



LatticeECP2/M Family Handbook

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Section I. LatticeECP2/M Family Data Sheet

Introduction

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Section I. LatticeECP2/M Family Data Sheet

Version 03.9, January 2011

Features

- **High Logic Density for System Integration**
 - 6K to 95K LUTs
 - 90 to 583 I/Os
- **Embedded SERDES (LatticeECP2M Only)**
 - Data Rates 250 Mbps to 3.125 Gbps
 - Up to 16 channels per device
PCI Express, Ethernet (1GbE, SGMII), OBSAI, CPRI and Serial RapidIO.
- **sysDSP™ Block**
 - 3 to 42 blocks for high performance multiply and accumulate
 - Each block supports
 - One 36x36, four 18x18 or eight 9x9 multipliers
- **Flexible Memory Resources**
 - 55Kbits to 5308Kbits sysMEM™ Embedded Block RAM (EBR)
 - 18Kbit block
 - Single, pseudo dual and true dual port
 - Byte Enable Mode support
 - 12K to 202Kbits distributed RAM
 - Single port and pseudo dual port
- **sysCLOCK Analog PLLs and DLLs**
 - Two GPLLs and up to six SPLLs per device
 - Clock multiply, divide, phase & delay adjust
 - Dynamic PLL adjustment
 - Two general purpose DLLs per device
- **Pre-Engineered Source Synchronous I/O**
 - DDR registers in I/O cells
 - Dedicated gearing logic
 - Source synchronous standards support
 - SPI4.2, SF14 (DDR Mode), XGMII
 - High Speed ADC/DAC devices
 - Dedicated DDR and DDR2 memory support
 - DDR1: 400 (200MHz) / DDR2: 533 (266MHz)
 - Dedicated DQS support
- **Programmable sysI/O™ Buffer Supports Wide Range Of Interfaces**
 - LVTTTL and LVCMOS 33/25/18/15/12
 - SSTL 3/2/18 I, II
 - HSTL15 I and HSTL18 I, II
 - PCI and Differential HSTL, SSTL
 - LVDS, RSDS, Bus-LVDS, MLVDS, LVPECL
- **Flexible Device Configuration**
 - 1149.1 Boundary Scan compliant
 - Dedicated bank for configuration I/Os
 - SPI boot flash interface
 - Dual boot images supported
 - TransFR™ I/O for simple field updates
 - Soft Error Detect macro embedded
- **Optional Bitstream Encryption (LatticeECP2/M “S” Versions Only)**
- **System Level Support**
 - ispTRACY™ internal logic analyzer capability
 - On-chip oscillator for initialization & general use
 - 1.2V power supply

Table 1-1. LatticeECP2 (Including “S-Series”) Family Selection

| Device | ECP2-6 | ECP2-12 | ECP2-20 | ECP2-35 | ECP2-50 | ECP2-70 |
|--------------------------------------|--------|---------|---------|---------|---------|---------|
| LUTs (K) | 6 | 12 | 21 | 32 | 48 | 68 |
| Distributed RAM (Kbits) | 12 | 24 | 42 | 64 | 96 | 136 |
| EBR SRAM (Kbits) | 55 | 221 | 276 | 332 | 387 | 1032 |
| EBR SRAM Blocks | 3 | 12 | 15 | 18 | 21 | 60 |
| sysDSP Blocks | 3 | 6 | 7 | 8 | 18 | 22 |
| 18x18 Multipliers | 12 | 24 | 28 | 32 | 72 | 88 |
| GPLL + SPLL + DLL | 2+0+2 | 2+0+2 | 2+0+2 | 2+0+2 | 2+2+2 | 2+4+2 |
| Maximum Available I/O | 190 | 297 | 402 | 450 | 500 | 583 |
| Packages and I/O Combinations | | | | | | |
| 144-pin TQFP (20 x 20 mm) | 90 | 93 | | | | |
| 208-pin PQFP (28 x 28 mm) | | 131 | 131 | | | |
| 256-ball fpBGA (17 x 17 mm) | 190 | 193 | 193 | | | |
| 484-ball fpBGA (23 x 23 mm) | | 297 | 331 | 331 | 339 | |
| 672-ball fpBGA (27 x 27 mm) | | | 402 | 450 | 500 | 500 |
| 900-ball fpBGA (31 x 31 mm) | | | | | | 583 |

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Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

| Device | ECP2M20 | ECP2M35 | ECP2M50 | ECP2M70 | ECP2M100 |
|---|---------|---------|---------|----------|----------|
| LUTs (K) | 19 | 34 | 48 | 67 | 95 |
| sysMEM Blocks (18kb) | 66 | 114 | 225 | 246 | 288 |
| Embedded Memory (Kbits) | 1217 | 2101 | 4147 | 4534 | 5308 |
| Distributed Memory (Kbits) | 41 | 71 | 101 | 145 | 202 |
| sysDSP Blocks | 6 | 8 | 22 | 24 | 42 |
| 18x18 Multipliers | 24 | 32 | 88 | 96 | 168 |
| GPLL+SPLL+DLL | 2+6+2 | 2+6+2 | 2+6+2 | 2+6+2 | 2+6+2 |
| Maximum Available I/O | 304 | 410 | 410 | 436 | 520 |
| Packages and SERDES / I/O Combinations | | | | | |
| 256-ball fpBGA (17 x 17 mm) | 4 / 140 | 4 / 140 | | | |
| 484-ball fpBGA (23 x 23 mm) | 4 / 304 | 4 / 303 | 4 / 270 | | |
| 672-ball fpBGA (27 x 27 mm) | | 4 / 410 | 8 / 372 | | |
| 900-ball fpBGA (31 x 31 mm) | | | 8 / 410 | 16 / 416 | 16 / 416 |
| 1152-ball fpBGA (35 x 35 mm) | | | | 16 / 436 | 16 / 520 |

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

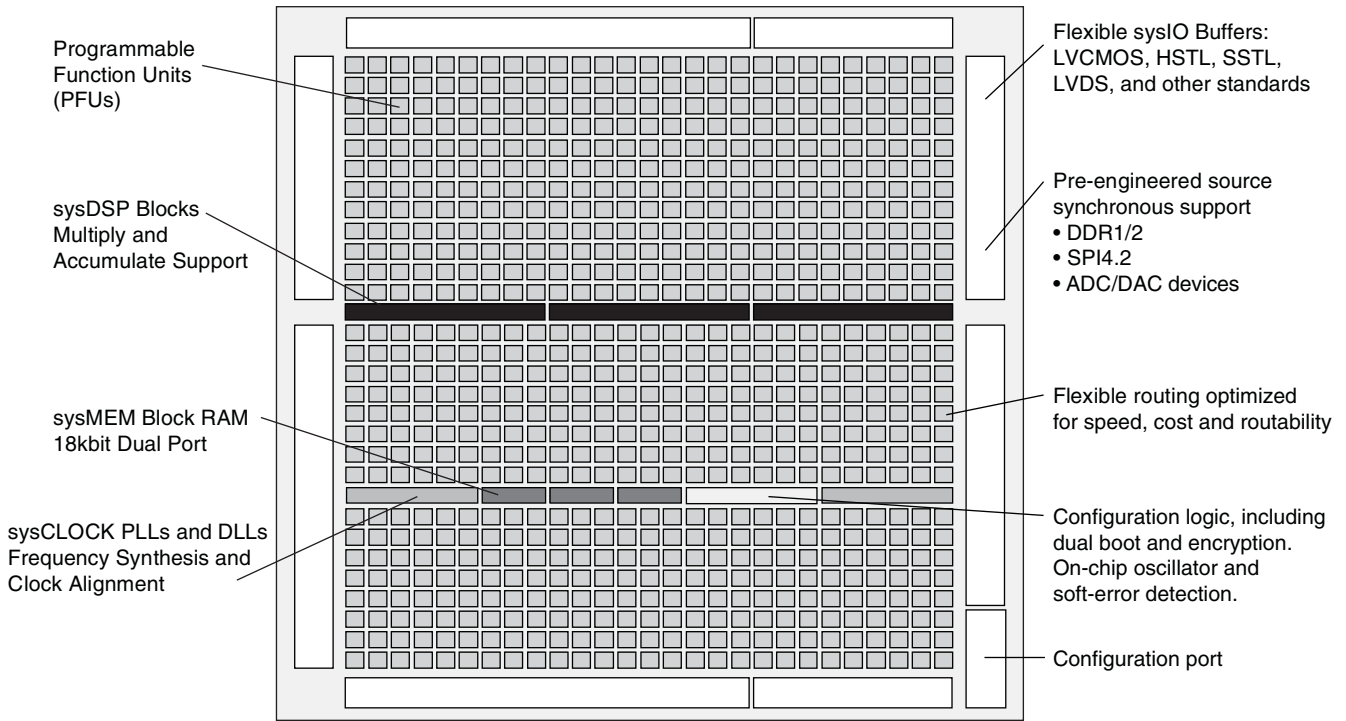
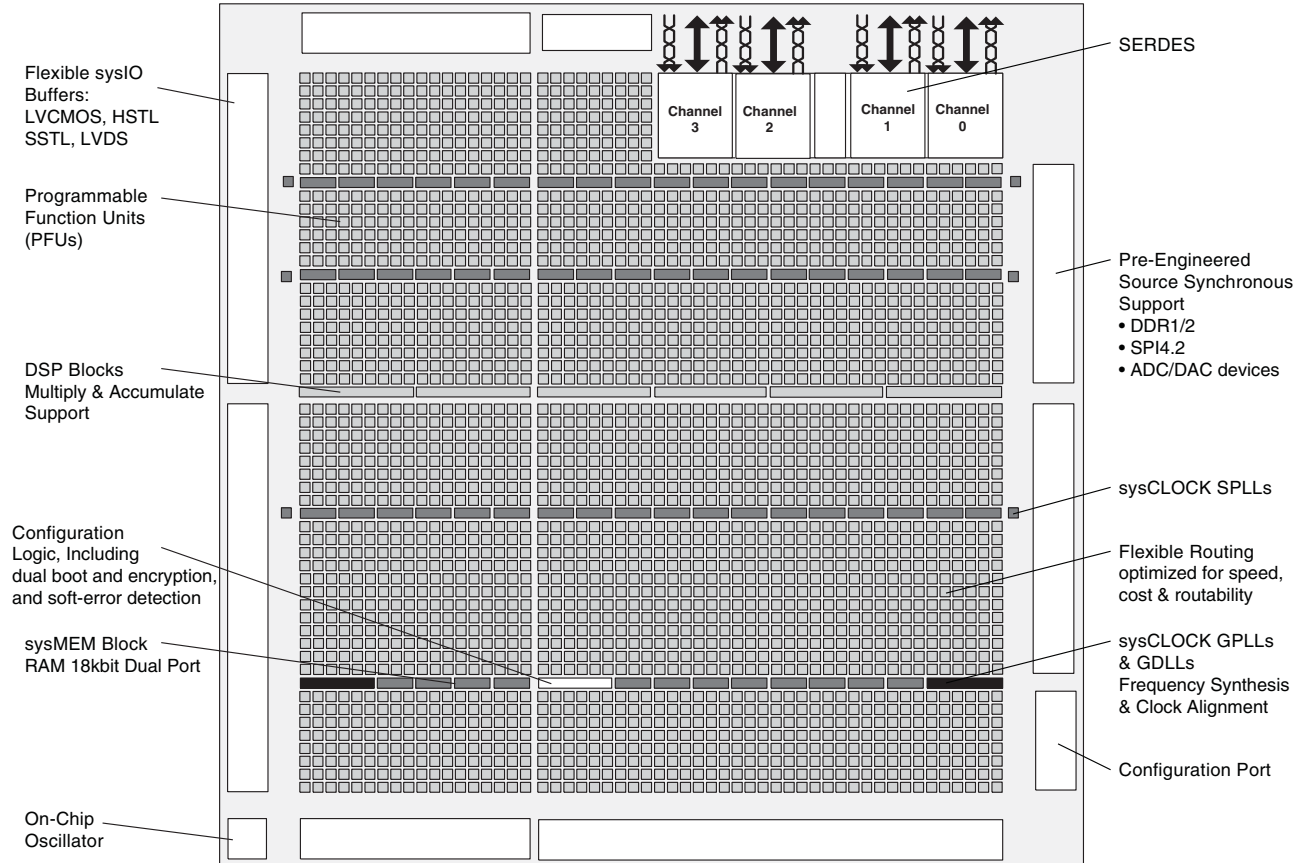


Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)

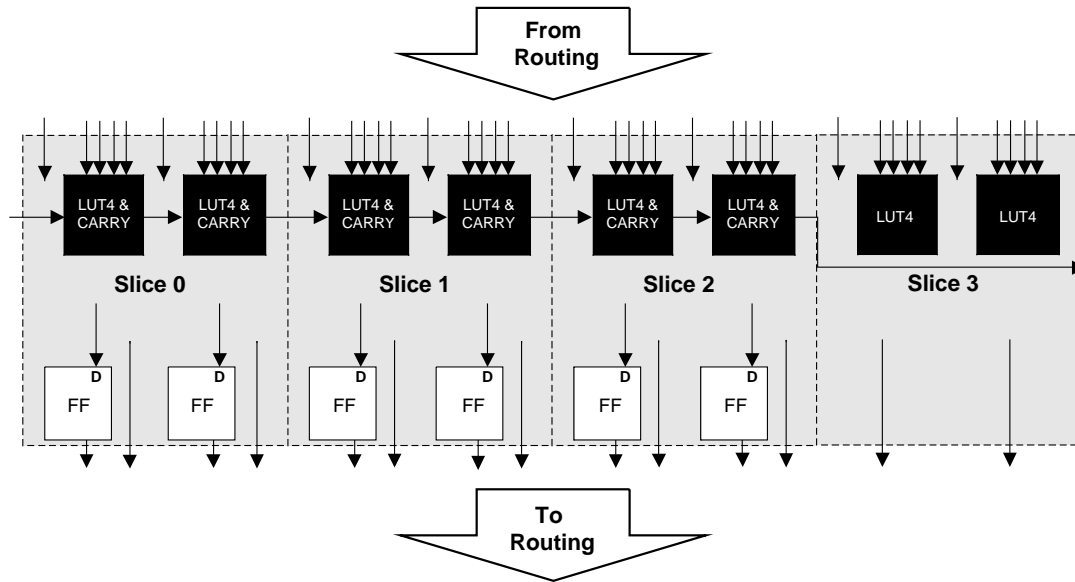


PFU Blocks

The core of the LatticeECP2/M device consists of PFU blocks, which are provided in two forms, the PFU and PFF. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of this data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 50 inputs and 23 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

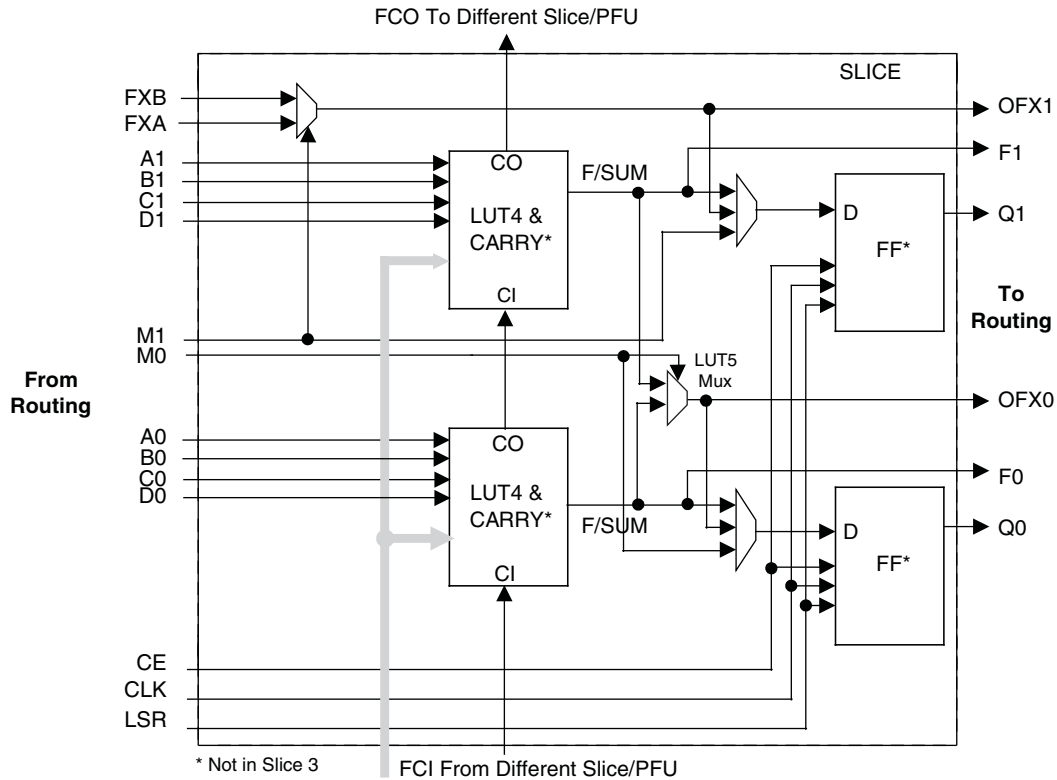
Slice 0 through Slice 2 contain two LUT4s feeding two registers, whereas Slice 3 contains two LUT4s only. For PFUs, Slice 0 and Slice 2 can also be configured as distributed memory, a capability not available in the PFF. Table 2-1 shows the capability of the slices in both PFF and PFU blocks along with the operation modes they enable. In addition, each PFU contains some logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge triggered or level sensitive clocks.

Table 2-1. Resources and Modes Available per Slice

| Slice | PFU BLock | | PFF Block | |
|---------|-------------------------|-------------------------|-------------------------|--------------------|
| | Resources | Modes | Resources | Modes |
| Slice 0 | 2 LUT4s and 2 Registers | Logic, Ripple, RAM, ROM | 2 LUT4s and 2 Registers | Logic, Ripple, ROM |
| Slice 1 | 2 LUT4s and 2 Registers | Logic, Ripple, ROM | 2 LUT4s and 2 Registers | Logic, Ripple, ROM |
| Slice 2 | 2 LUT4s and 2 Registers | Logic, Ripple, RAM, ROM | 2 LUT4s and 2 Registers | Logic, Ripple, ROM |
| Slice 3 | 2 LUT4s | Logic, ROM | 2 LUT4s | Logic, ROM |

Slices 0, 1 and 2 have 14 input signals: 13 signals from routing and one from the carry-chain (from the adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to the adjacent PFU). Slice 3 has 13 input signals from routing and four signals to routing. Table 2-2 lists the signals associated with Slice 0 to Slice 2.

Figure 2-4. Slice Diagram



* Not in Slice 3
FCI From Different Slice/PFU

For Slices 0 and 2, memory control signals are generated from Slice 1 as follows:
 WCK is CLK
 WRE is from LSR
 DI[3:2] for Slice 2 and DI[1:0] for Slice 0 data
 WAD [A:D] is a 4bit address from slice 1 LUT input

Table 2-2. Slice Signal Descriptions

| Function | Type | Signal Names | Description |
|----------|--------------------|----------------|--|
| Input | Data signal | A0, B0, C0, D0 | Inputs to LUT4 |
| Input | Data signal | A1, B1, C1, D1 | Inputs to LUT4 |
| Input | Multi-purpose | M0 | Multipurpose Input |
| Input | Multi-purpose | M1 | Multipurpose Input |
| Input | Control signal | CE | Clock Enable |
| Input | Control signal | LSR | Local Set/Reset |
| Input | Control signal | CLK | System Clock |
| Input | Inter-PFU signal | FC | Fast Carry-in ¹ |
| Input | Inter-slice signal | FXA | Intermediate signal to generate LUT6 and LUT7 |
| Input | Inter-slice signal | FXB | Intermediate signal to generate LUT6 and LUT7 |
| Output | Data signals | F0, F1 | LUT4 output register bypass signals |
| Output | Data signals | Q0, Q1 | Register outputs |
| Output | Data signals | OFX0 | Output of a LUT5 MUX |
| Output | Data signals | OFX1 | Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice |
| Output | Inter-PFU signal | FCO | Slice 2 of each PFU is the fast carry chain output ¹ |

1. See Figure 2-4 for connection details.
 2. Requires two PFUs.

Modes of Operation

Each slice has up to four potential modes of operation: Logic, Ripple, RAM and ROM.

Logic Mode

In this mode, the LUTs in each slice are configured as 4-input combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any four input logic functions can be generated by programming this lookup table. Since there are two LUT4s per slice, a LUT5 can be constructed within one slice. Larger look-up tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other slices. Note LUT8 requires more than four slices.

Ripple Mode

Ripple mode supports the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each slice:

- Addition 2-bit
- Subtraction 2-bit
- Add/Subtract 2-bit using dynamic control
- Up counter 2-bit
- Down counter 2-bit
- Up/Down counter with Async clear
- Up/Down counter with preload (sync)
- Ripple mode multiplier building block
- Multiplier support
- Comparator functions of A and B inputs
 - A greater-than-or-equal-to B
 - A not-equal-to B
 - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, a 16x4-bit distributed single port RAM (SPR) can be constructed using each LUT block in Slice 0 and Slice 2 as a 16x1-bit memory. Slice 1 is used to provide memory address and control signals. A 16x2-bit pseudo dual port RAM (PDPR) memory is created by using one Slice as the read-write port and the other companion slice as the read-only port.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the PFU. Table 2-3 shows the number of slices required to implement different distributed RAM primitives. For more information about using RAM in LatticeECP2/M devices, please see the list of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required to Implement Distributed RAM

| | SPR 16X4 | PDPR 16X4 |
|------------------|----------|-----------|
| Number of slices | 3 | 3 |

Note: SPR = Single Port RAM, PDPR = Pseudo Dual Port RAM

ROM Mode

ROM mode uses the LUT logic; hence, Slices 0 through 3 can be used in ROM mode. Preloading is accomplished through the programming interface during PFU configuration.

Routing

There are many resources provided in the LatticeECP2/M devices to route signals individually or as buses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, allowing the routing of both short and long connections between PFUs.

The LatticeECP2/M family has an enhanced routing architecture that produces a compact design. The Diamond design software takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

sysCLOCK Phase Locked Loops (GPLL/SPLL)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. All the devices in the LatticeECP2/M family support two General Purpose PLLs (GPLLs) which are full-featured PLLs. In addition, some of the larger devices have two to six Standard PLLs (SPLLs) that have a subset of GPLL functionality.

General Purpose PLL (GPLL)

The architecture of the GPLL is shown in Figure 2-5. A description of the GPLL functionality follows.

CLKI is the reference frequency (generated either from the pin or from routing) for the PLL. CLKI feeds into the Input Clock Divider block. The CLKFB is the feedback signal (generated from CLKOP or from a user clock PIN/logic). This signal feeds into the Feedback Divider. The Feedback Divider is used to multiply the reference frequency.

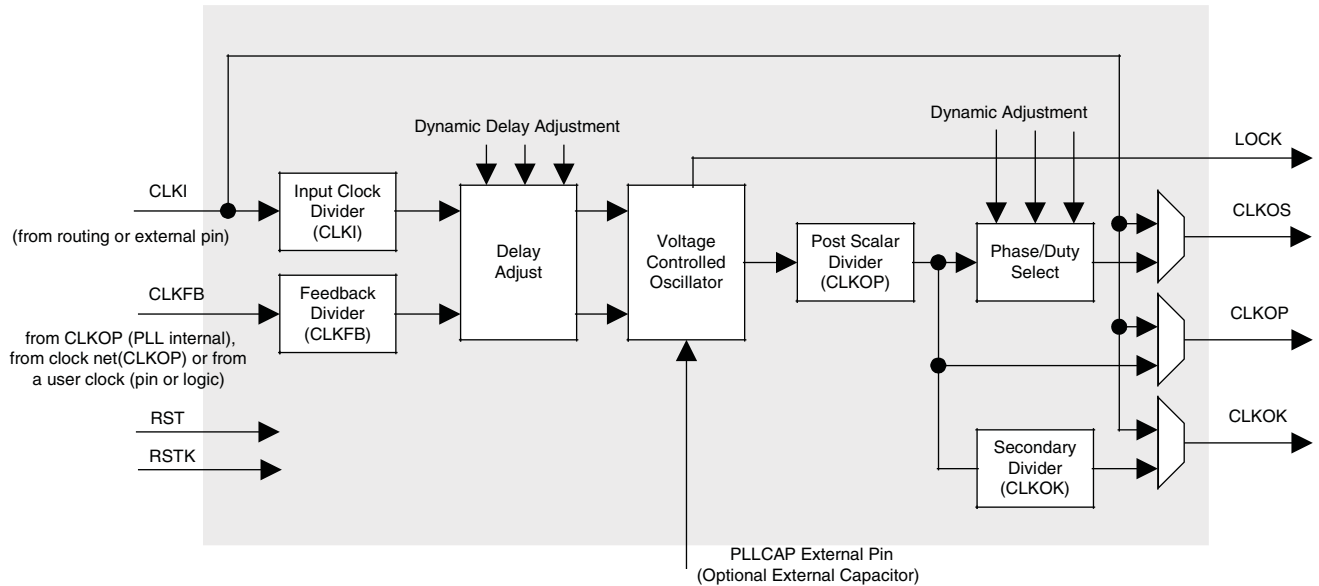
The Delay Adjust Block adjusts either the delays of the reference or feedback signals. The Delay Adjust Block can either be programmed during configuration or can be adjusted dynamically. The setup, hold or clock-to-out times of the device can be improved by programming a delay in the feedback or input path of the PLL, which will advance or delay the output clock with reference to the input clock.

Following the Delay Adjust Block, both the input path and feedback signals enter the Voltage Controlled Oscillator (VCO) block. In this block the difference between the input path and feedback signals is used to control the frequency and phase of the oscillator. A LOCK signal is generated by the VCO to indicate that the VCO has locked onto the input clock signal. In dynamic mode, the PLL may lose lock after a dynamic delay adjustment and not relock until the t_{LOCK} parameter has been satisfied. LatticeECP2/M devices have two dedicated pins on the left and right edges of the device for connecting optional external capacitors to the VCO. This allows the PLLs to operate at a lower frequency. This is a shared resource that can only be used by one PLL (GPLL or SPLL) per side.

The output of the VCO then enters the post-scalar divider. The post-scalar divider allows the VCO to operate at higher frequencies than the clock output (CLKOP), thereby increasing the frequency range. A secondary divider takes the CLKOP signal and uses it to derive lower frequency outputs (CLKOK). The Phase/Duty Select block adjusts the phase and duty cycle of the CLKOP signal and generates the CLKOS signal. The phase/duty cycle setting can be pre-programmed or dynamically adjusted.

The primary output from the post scalar divider CLKOP along with the outputs from the secondary divider (CLKOK) and Phase/Duty select (CLKOS) are fed to the clock distribution network.

Figure 2-5. General Purpose PLL (GPLL) Diagram



Standard PLL (SPLL)

Some of the larger devices have two to six Standard PLLs (SPLLs). SPLLs have the same features as GPLLs but without delay adjustment capability. SPLLs also provide different parametric specifications. For more information, please see the list of additional technical documentation at the end of this data sheet.

Table 2-4 provides a description of the signals in the GPLL and SPLL blocks.

Table 2-4. GPLL and SPLL Blocks Signal Descriptions

| Signal | I/O | Description |
|---------------------------|-----|--|
| CLKI | I | Clock input from external pin or routing |
| CLKFB | I | PLL feedback input from CLKOP (PLL internal), from clock net (CLKOP) or from a user clock (PIN or logic) |
| RST | I | "1" to reset PLL counters, VCO, charge pumps and M-dividers |
| RSTK | I | "1" to reset K-divider |
| CLKOS | O | PLL output clock to clock tree (phase shifted/duty cycle changed) |
| CLKOP | O | PLL output clock to clock tree (no phase shift) |
| CLKOK | O | PLL output to clock tree through secondary clock divider |
| LOCK | O | "1" indicates PLL LOCK to CLKI |
| DDAMODE ¹ | I | Dynamic Delay Enable. "1": Pin control (dynamic), "0": Fuse Control (static) |
| DDAIZR ¹ | I | Dynamic Delay Zero. "1": delay = 0, "0": delay = on |
| DDAILAG ¹ | I | Dynamic Delay Lag/Lead. "1": Lead, "0": Lag |
| DDAIDEL[2:0] ¹ | I | Dynamic Delay Input |
| DPA MODES | I | DPA (Dynamic Phase Adjust/Duty Cycle Select) mode |
| DPHASE [3:0] | I | DPA Phase Adjust inputs |
| DDDUTY [3:0] | — | DPA Duty Cycle Select inputs |

1. These signals are not available in SPLL.

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)

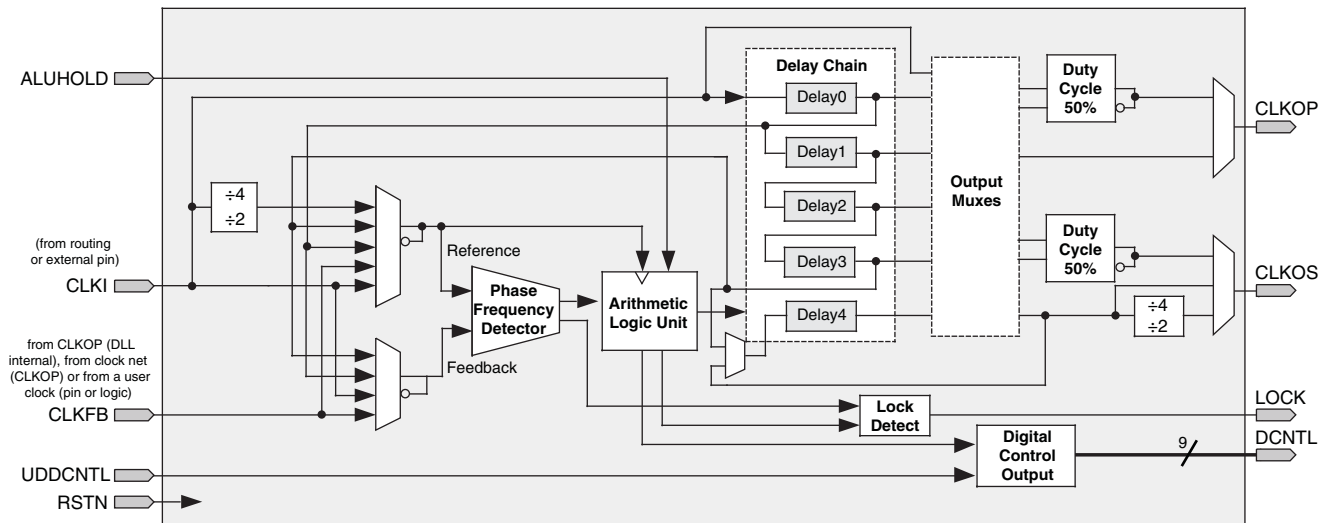


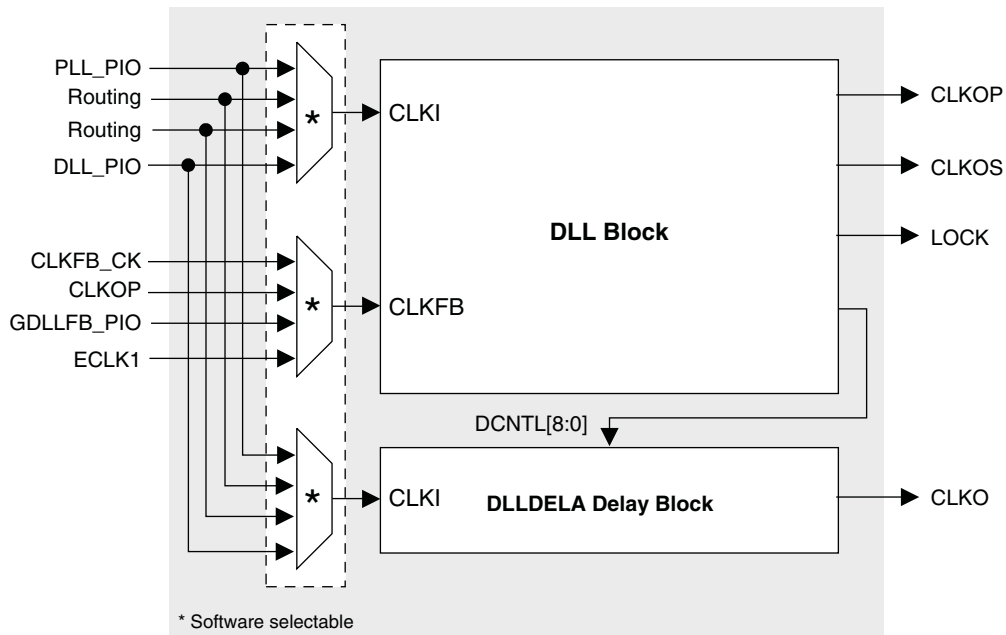
Table 2-5. DLL Signals

| Signal | I/O | Description |
|------------|-----|---|
| CLKI | I | Clock input from external pin or routing |
| CLKFB | I | DLL feed input from DLL output, clock net, routing or external pin |
| RSTN | I | Active low synchronous reset |
| ALUHOLD | I | Active high freezes the ALU |
| UDDCNTL | I | Synchronous enable signal (hold high for two cycles) from routing |
| DCNTL[8:0] | O | Encoded digital control signals for PIC INDEL and slave delay calibration |
| CLKOP | O | The primary clock output |
| CLKOS | O | The secondary clock output with fine phase shift and/or division by 2 or by 4 |
| LOCK | O | Active high phase lock indicator |

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block



PLL/DLL Cascading

LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

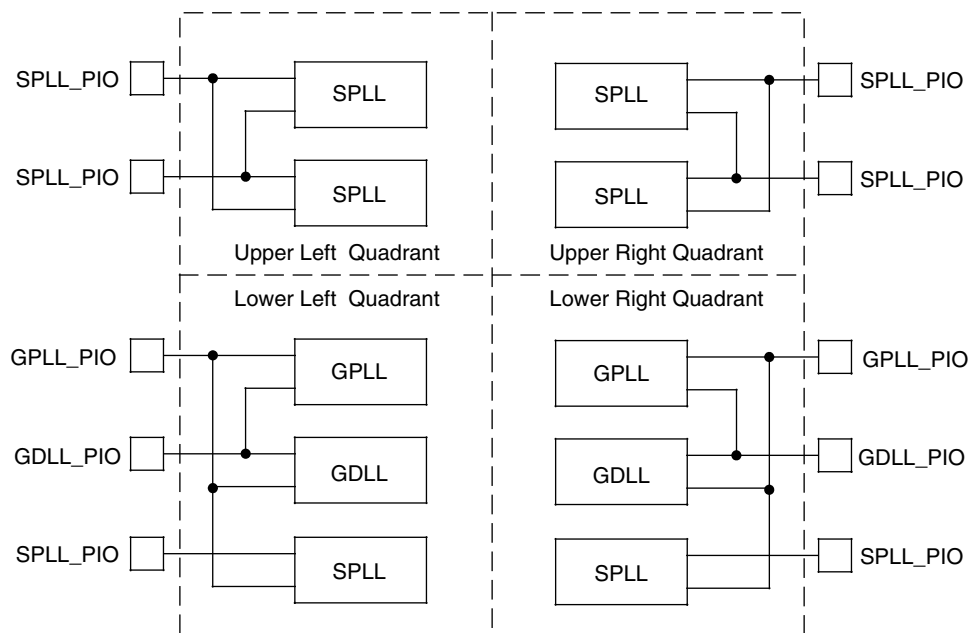
The DLLs in the LatticeECP2/M are used to shift the clock in relation to the data for source synchronous inputs. PLLs are used for frequency synthesis and clock generation for source synchronous interfaces. Cascading PLL and DLL blocks allows applications to utilize the unique benefits of both DLLs and PLLs.

For further information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

GPLL/SPLL/GDLL PIO Input Pin Connections (LatticeECP2M Family Only)

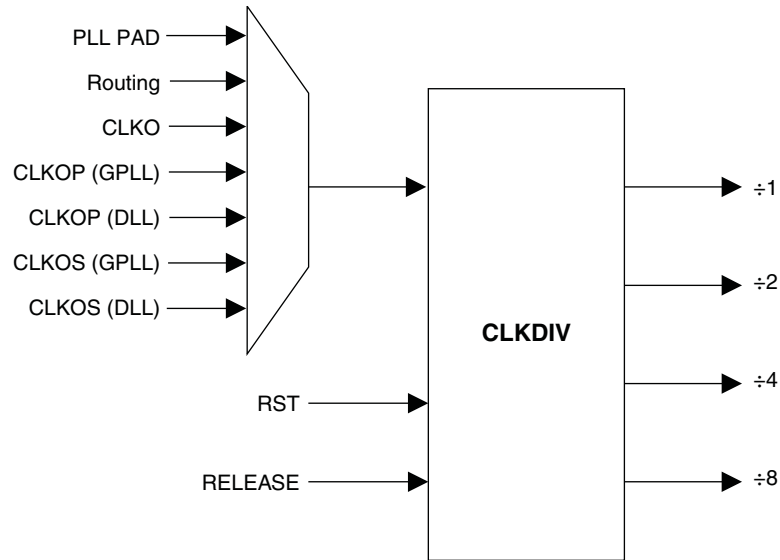
All LatticeECP2M devices contain two GDLLs, two GPLLs and six SPLLs, arranged in quadrants as shown in Figure 2-8. In the LatticeECP2M devices GPLLs, SPLLs and GDLLs share their input pins. Figure 2-8 shows the sharing of SPLLs input pin connections in the upper two quadrants and the sharing of GDLL, GPLL and SPLL input pin connections in the lower two quadrants.

Figure 2-8. Sharing of PIO Pins by GPLL, SPLL and GDLL in LatticeECP2M Devices



Clock Dividers

LatticeECP2/M devices have two clock dividers, one on the left side and one on the right side of the device. These are intended to generate a slower-speed system clock from a high-speed edge clock. The block operates in a $\div 2$, $\div 4$ or $\div 8$ mode and maintains a known phase relationship between the divided down clock and the high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PLL/DLL outputs, DLL-DELA delay blocks, routing or from an external clock input. The clock divider outputs serve as primary clock sources and feed into the clock distribution network. The Reset (RST) control signal resets input and synchronously forces all outputs to low. The RELEASE signal releases outputs synchronously to the input clock. For further information about clock dividers, please see the list of additional technical documentation at the end of this data sheet. Figure 2-9 shows the clock divider connections.

Figure 2-9. Clock Divider Connections

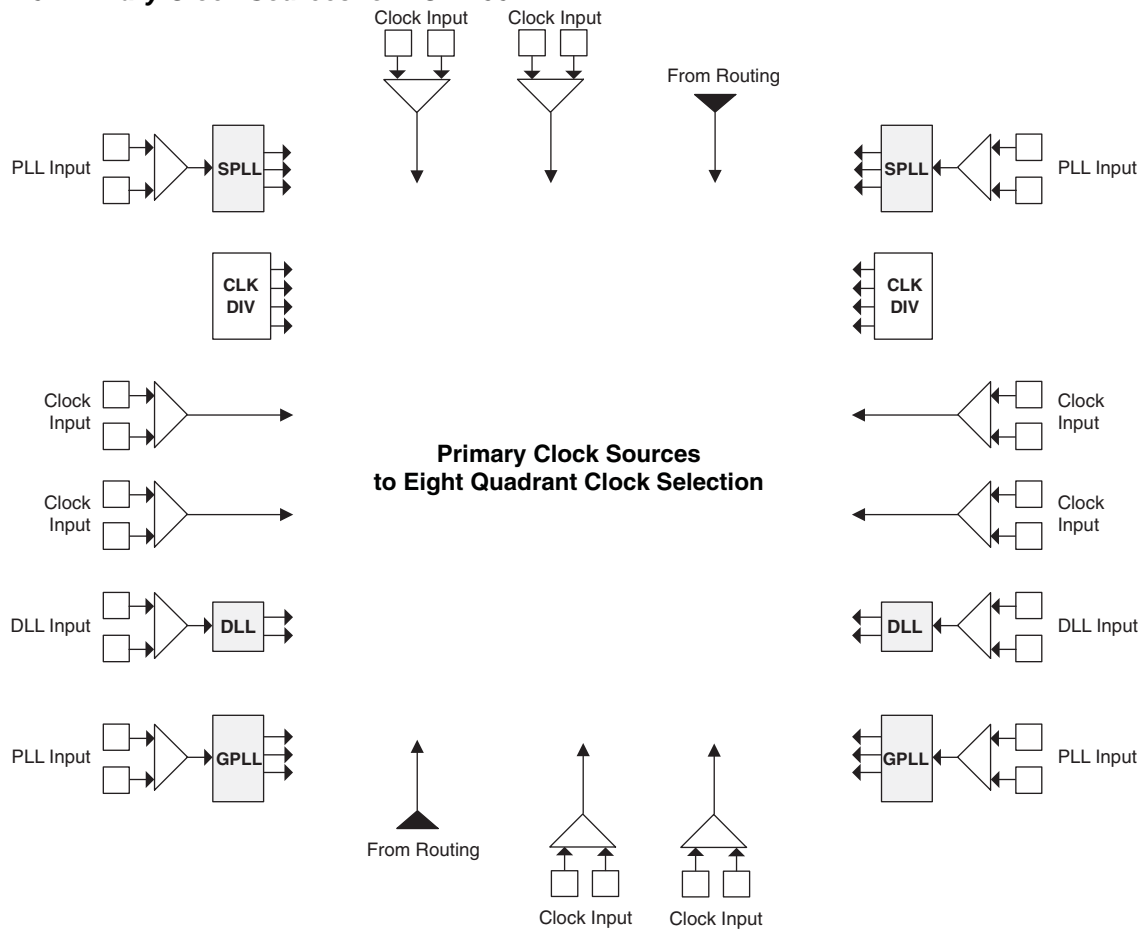
Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLK-DIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

Figure 2-10. Primary Clock Sources for ECP2-50

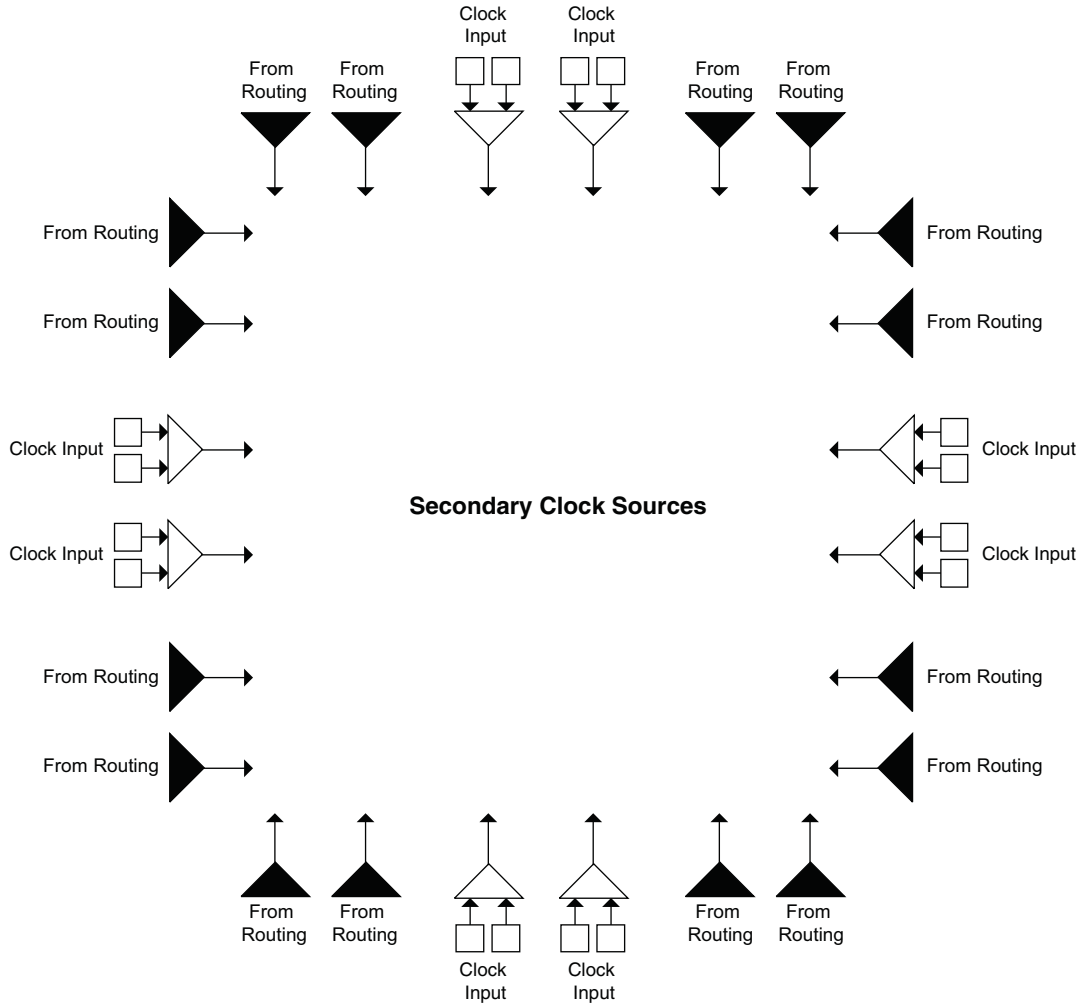


Note: This diagram shows sources for the ECP2-50 device. Smaller LatticeECP2 devices have fewer SPLLs. All LatticeECP2M device have six SPLLs.

Secondary Clock/Control Sources

LatticeECP2/M devices derive secondary clocks (SC0 through SC7) from eight dedicated clock input pads and the rest from routing. Figure 2-11 shows the secondary clock sources.

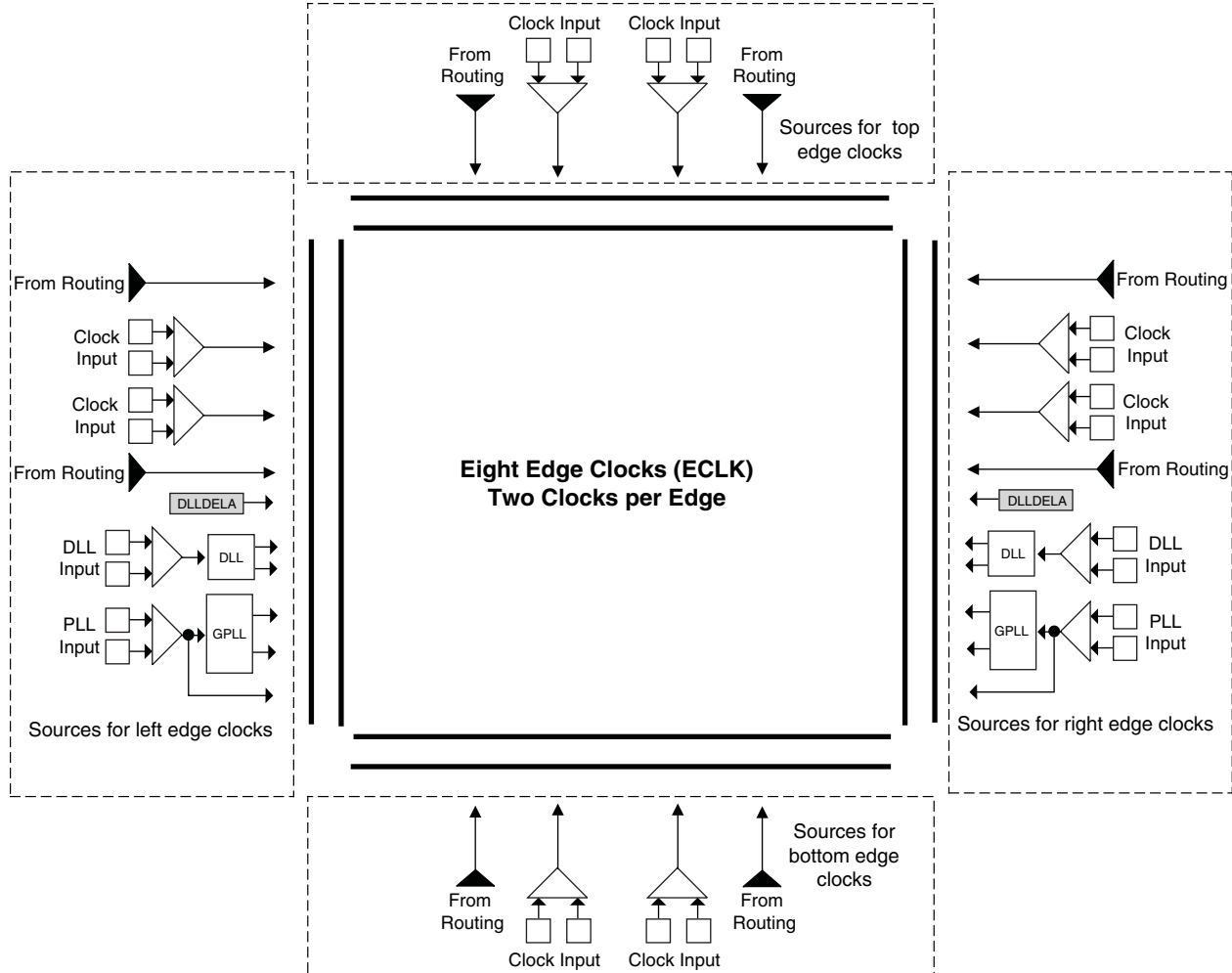
Figure 2-11. Secondary Clock Sources



Edge Clock Sources

Edge clock resources can be driven from a variety of sources at the same edge. Edge clock resources can be driven from adjacent edge clock PIOs, primary clock PIOs, PLLs/DLLs and clock dividers as shown in Figure 2-12.

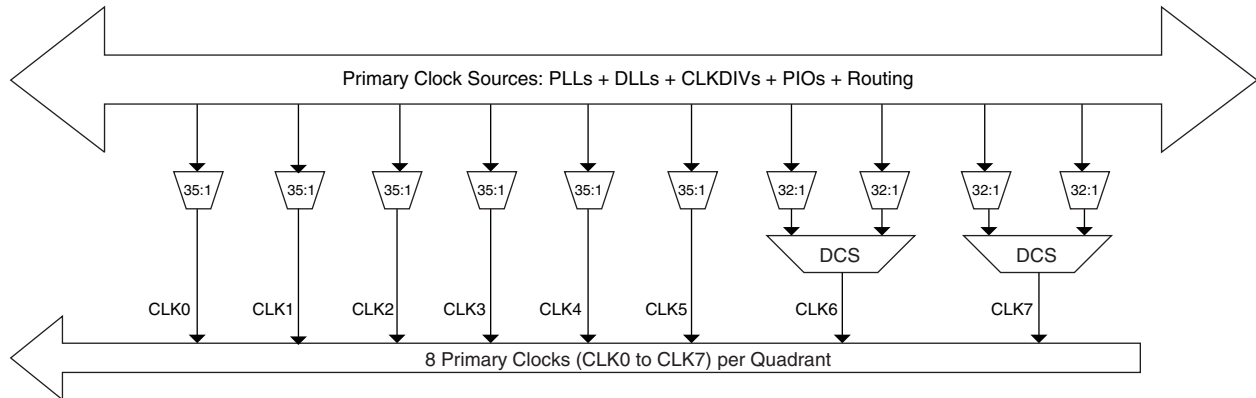
Figure 2-12. Edge Clock Sources



Primary Clock Routing

The clock routing structure in LatticeECP2/M devices consists of a network of eight primary clock lines (CLK0 through CLK7) per quadrant. The primary clocks of each quadrant are generated from muxes located in the center of the device. All the clock sources are connected to these muxes. Figure 2-13 shows the clock routing for one quadrant. Each quadrant mux is identical. If desired, any clock can be routed globally

Figure 2-13. Per Quadrant Primary Clock Selection

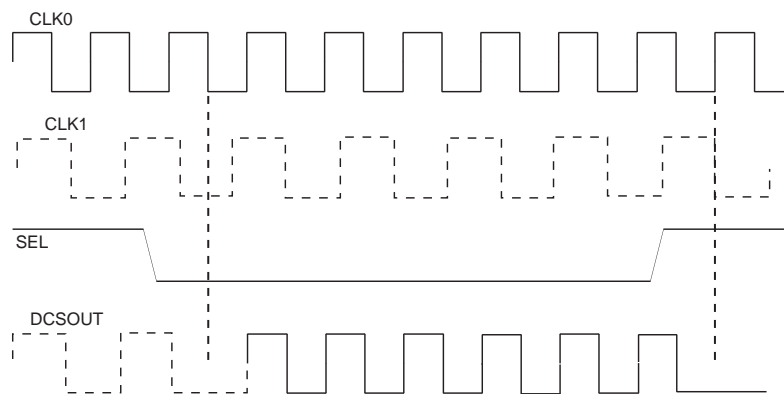


Dynamic Clock Select (DCS)

The DCS is a smart multiplexer function available in the primary clock routing. It switches between two independent input clock sources without any glitches or runt pulses. This is achieved regardless of when the select signal is toggled. There are two DCS blocks per quadrant; in total, there are eight DCS blocks per device. The inputs to the DCS block come from the center muxes. The output of the DCS is connected to primary clocks CLK6 and CLK7 (see Figure 2-13).

Figure 2-14 shows the timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-14. DCS Waveforms



Secondary Clock/Control Routing

Secondary clocks in the LatticeECP2 devices are region-based resources. The benefit of region-based resources is the relatively low injection delay and skew within the region, as compared to primary clocks. EBR/DSP rows and a special vertical routing channel bound the secondary clock regions. This special vertical routing channel aligns with either the left edge of the center DSP block in the DSP row or the center of the DSP row. Figure 2-15 shows

this special vertical routing channel and the eight secondary clock regions for the ECP2-50. LatticeECP2 devices have four secondary clocks (SC0 to SC3) which are distributed to every region.

The secondary clock muxes are located in the center of the device. Figure 2-16 shows the mux structure of the secondary clock routing. Secondary clocks SC0 to SC3 are used for clock and control and SC4 to SC7 are used for high fan-out signals.

Figure 2-15. Secondary Clock Regions ECP2-50

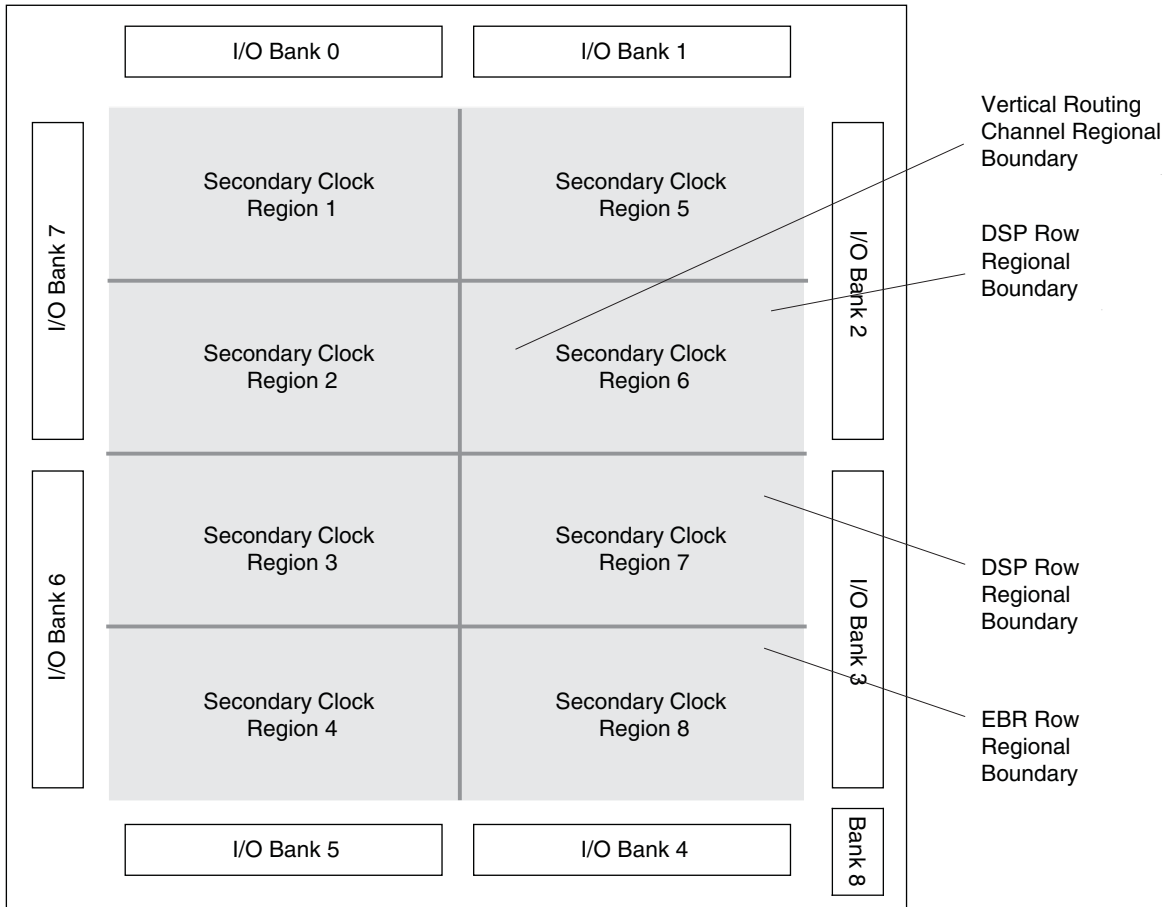
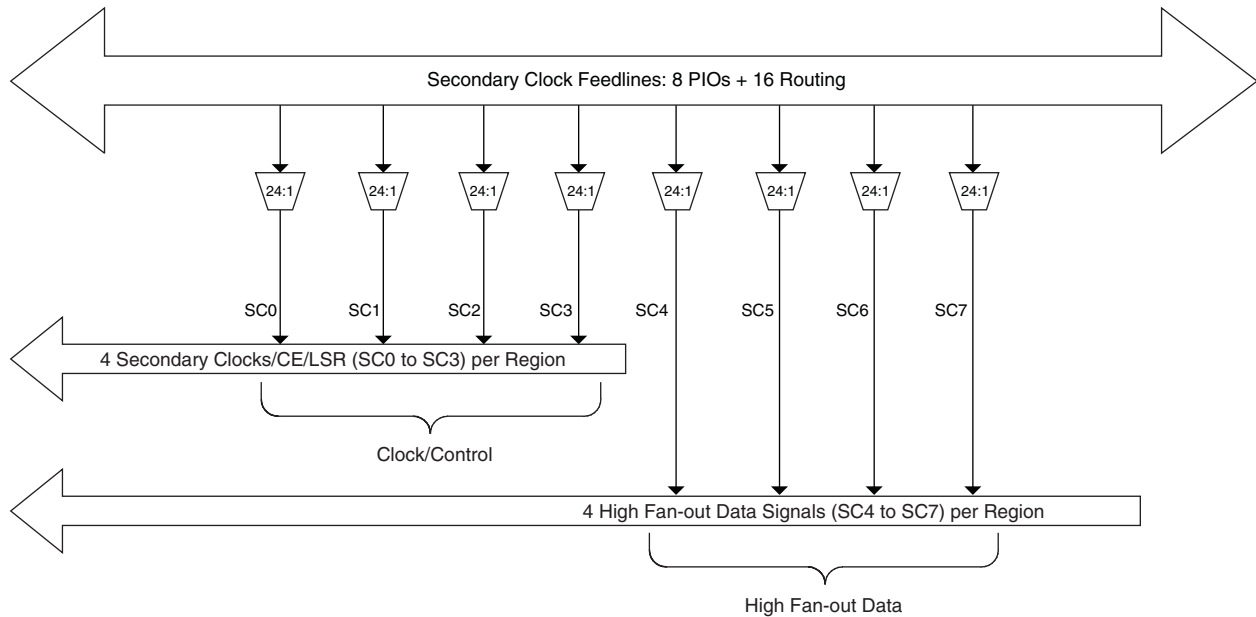


Figure 2-16. Secondary Clock Selection



Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

Figure 2-17. Slice0 through Slice2 Clock Selection

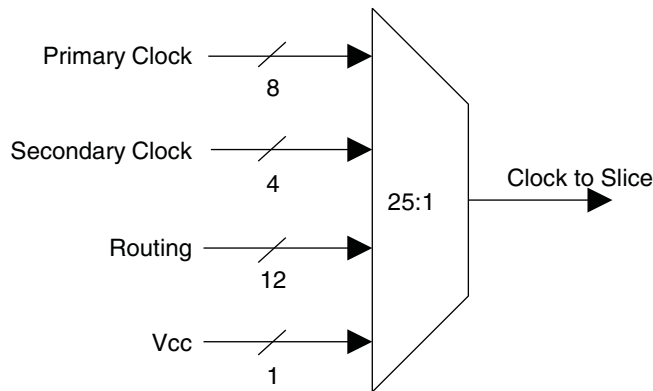
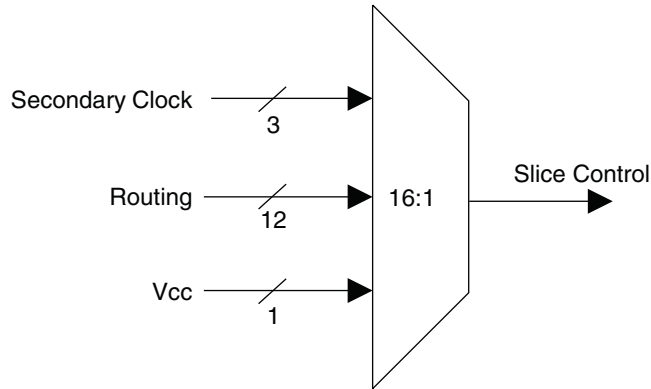


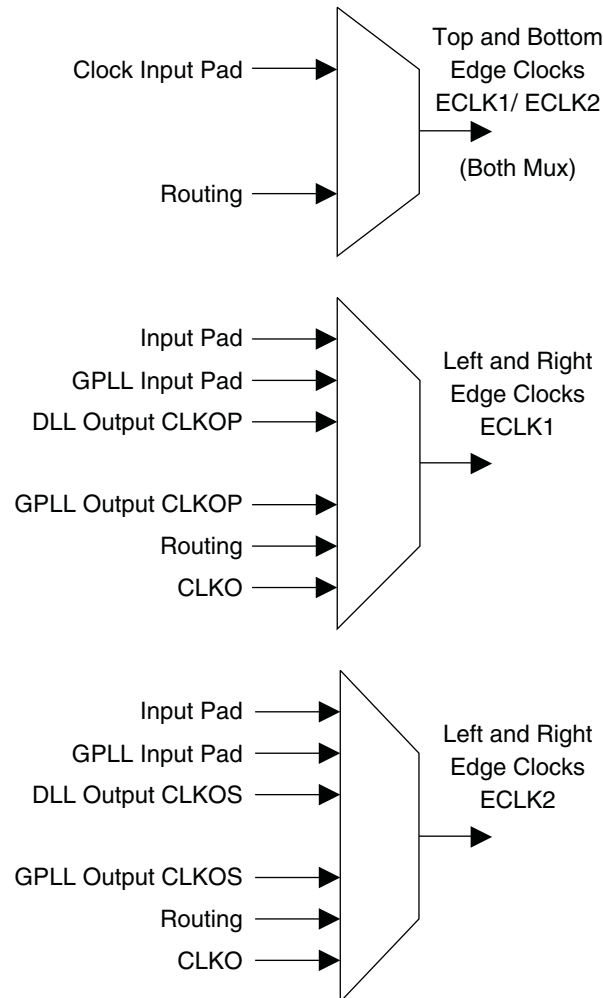
Figure 2-18. Slice0 through Slice2 Control Selection



Edge Clock Routing

LatticeECP2/M devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per device: two edge clocks per edge. Different PLL and DLL outputs are routed to the two muxes on the left and right sides of the device. In addition, the CLKO signal (generated from the DLLDELA block) is routed to all the edge clock muxes on the left and right sides of the device. Figure 2-19 shows the selection muxes for these clocks.

Figure 2-19. Edge Clock Mux Connections



sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

| Memory Mode | Configurations |
|------------------|----------------|
| Single Port | 16,384 x 1 |
| | 8,192 x 2 |
| | 4,096 x 4 |
| | 2,048 x 9 |
| | 1,024 x 18 |
| True Dual Port | 512 x 36 |
| | 16,384 x 1 |
| | 8,192 x 2 |
| | 4,096 x 4 |
| | 2,048 x 9 |
| Pseudo Dual Port | 1,024 x 18 |
| | 16,384 x 1 |
| | 8,192 x 2 |
| | 4,096 x 4 |
| | 2,048 x 9 |

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

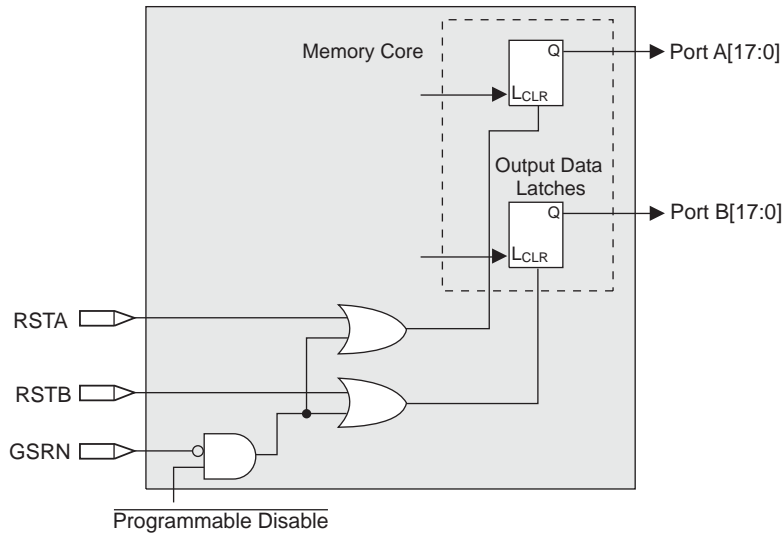
1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

2. Write Through – A copy of the input data appears at the output of the same port during a write cycle. This mode is supported for all data widths.

Memory Core Reset

The memory array in the EBR utilizes latches at the A and B output ports. These latches can be reset asynchronously or synchronously. RSTA and RSTB are local signals, which reset the output latches associated with Port A and Port B, respectively. The Global Reset (GSRN) signal resets both ports. The output data latches and associated resets for both ports are as shown in Figure 2-20.

Figure 2-20. Memory Core Reset

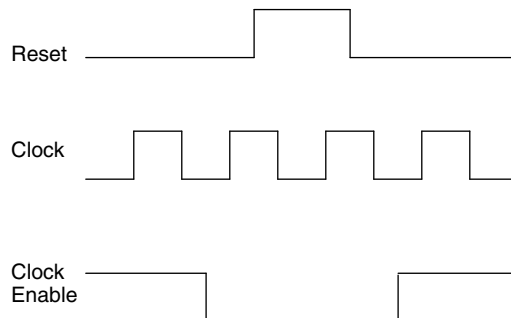


For further information about the sysMEM EBR block, please see the the list of additional technical documentation at the end of this data sheet.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-21. The GSR input to the EBR is always asynchronous.

Figure 2-21. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active.

These instructions apply to all EBR RAM and ROM implementations.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

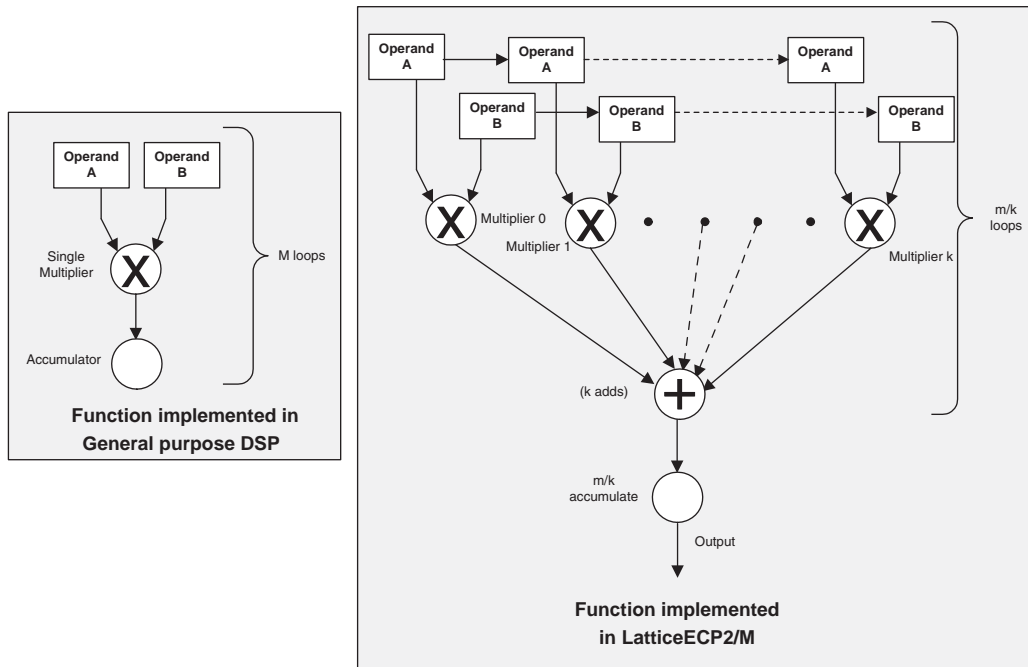
sysDSP™ Block

The LatticeECP2/M family provides a sysDSP block, making it ideally suited for low cost, high performance Digital Signal Processing (DSP) applications. Typical functions used in these applications are Finite Impulse Response (FIR) filters, Fast Fourier Transforms (FFT) functions, Correlators, Reed-Solomon/Turbo/Convolution encoders and decoders. These complex signal processing functions use similar building blocks such as multiply-adders and multiply-accumulators.

sysDSP Block Approach Compared to General DSP

Conventional general-purpose DSP chips typically contain one to four (Multiply and Accumulate) MAC units with fixed data-width multipliers; this leads to limited parallelism and limited throughput. Their throughput is increased by higher clock speeds. The LatticeECP2/M, on the other hand, has many DSP blocks that support different data-widths. This allows the designer to use highly parallel implementations of DSP functions. The designer can optimize the DSP performance vs. area by choosing an appropriate level of parallelism. Figure 2-22 compares the fully serial and the mixed parallel and serial implementations.

Figure 2-22. Comparison of General DSP and LatticeECP2/M Approaches



sysDSP Block Capabilities

The sysDSP block in the LatticeECP2/M family supports four functional elements in three 9, 18 and 36 data path widths. The user selects a function element for a DSP block and then selects the width and type (signed/unsigned) of its operands. The operands in the LatticeECP2/M family sysDSP Blocks can be either signed or unsigned but not mixed within a function element. Similarly, the operand widths cannot be mixed within a block. In the LatticeECP2/M family the DSP elements can be concatenated.

The resources in each sysDSP block can be configured to support the following elements:

- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

| Width of Multiply | x9 | x18 | x36 |
|-------------------|----|-----|-----|
| MULT | 8 | 4 | 1 |
| MAC | 2 | 2 | — |
| MULTADDSUB | 4 | 2 | — |
| MULTADDSUBSUM | 2 | 1 | — |

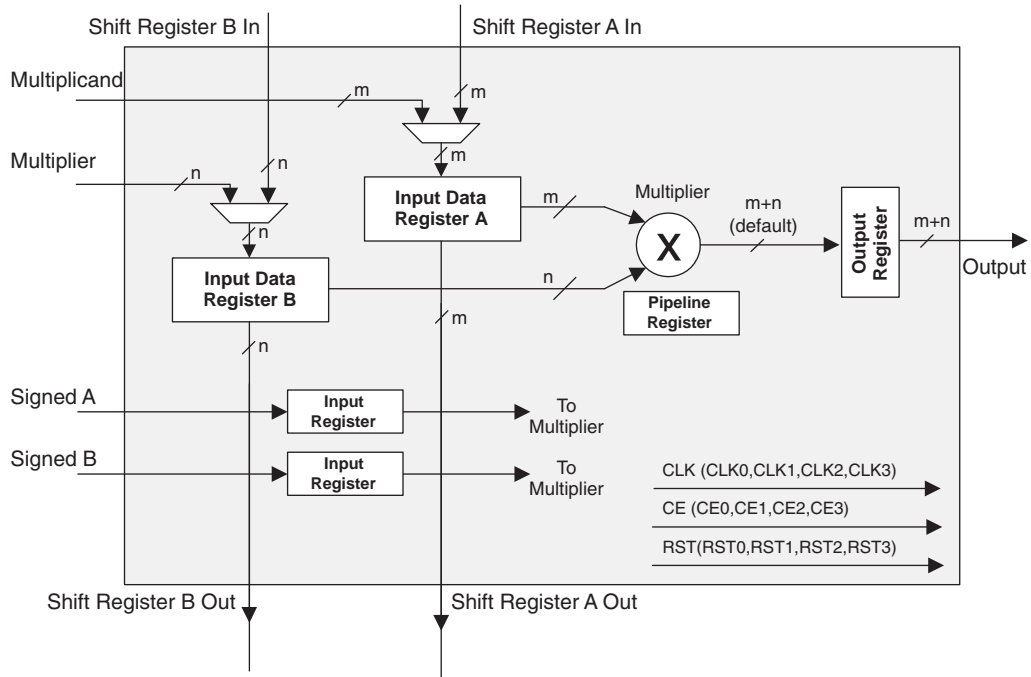
Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

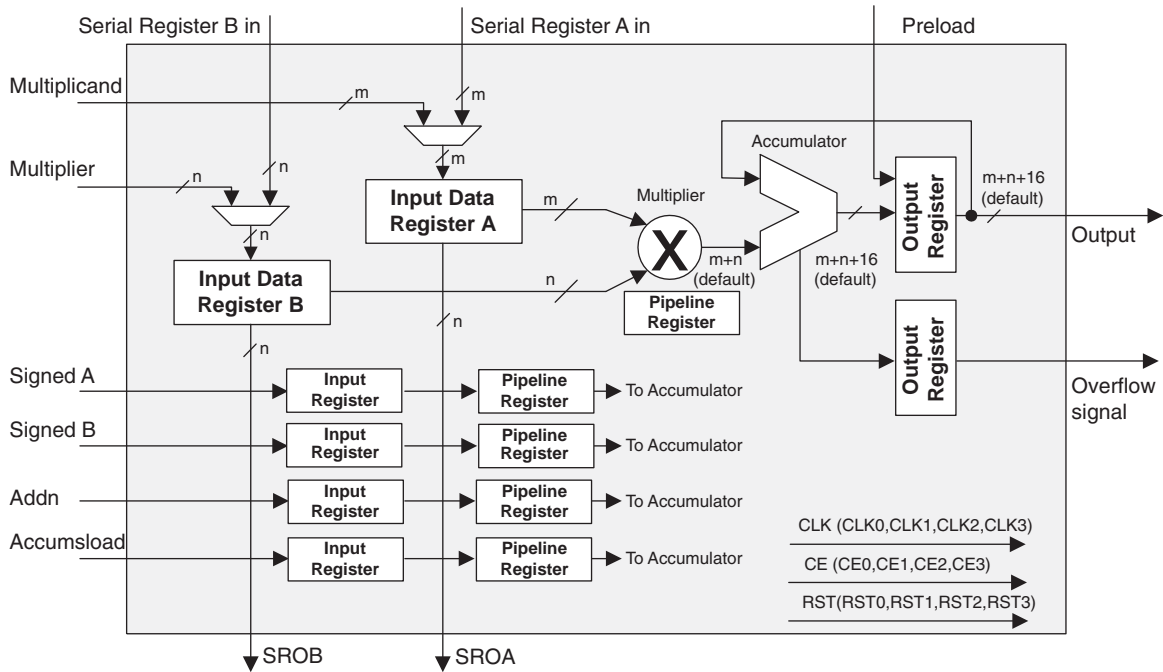
Figure 2-23. MULT sysDSP Element



MAC sysDSP Element

In this case, the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers, but the output register is always enabled. The output register is used to store the accumulated value. The Accumulators in the DSP blocks in the LatticeECP2/M family can be initialized dynamically. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-24 shows the MAC sysDSP element.

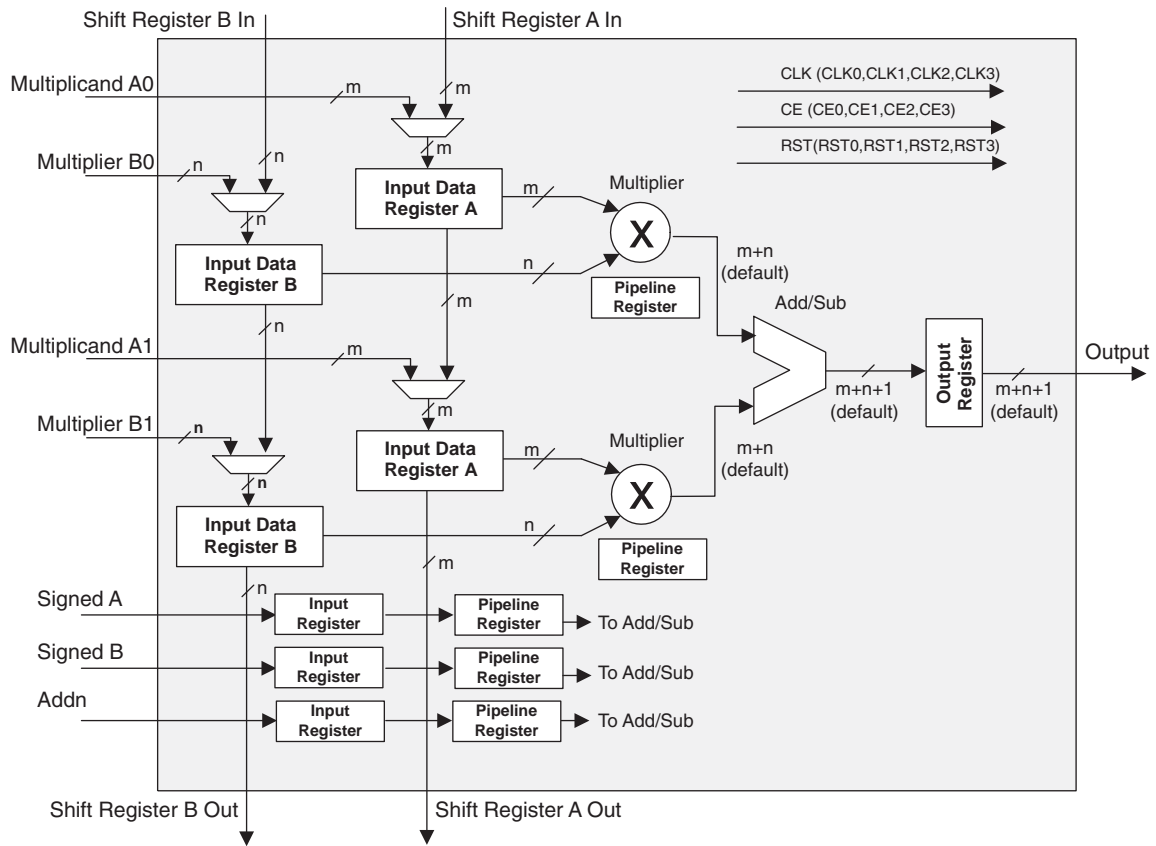
Figure 2-24. MAC sysDSP



MULTADDSUB sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-25 shows the MULTADDSUB sysDSP element.

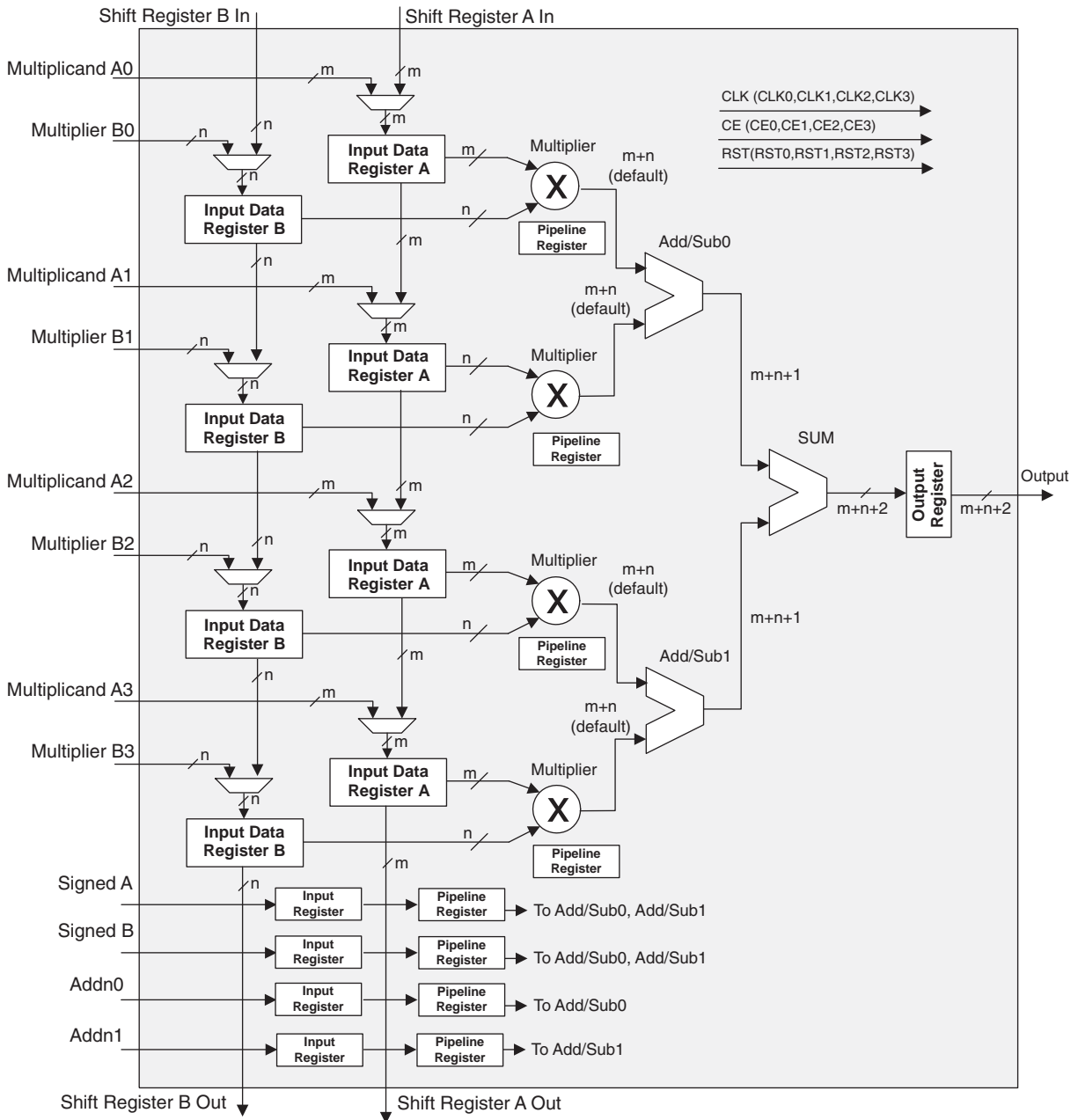
Figure 2-25. MULTADDSUB



MULTADDSUBSUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-26 shows the MULTADDSUBSUM sysDSP element.

Figure 2-26. MULTADDSUBSUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3)

one clock is selected for each input register, pipeline register and output register. Similarly Clock enable (CE) and Reset (RST) are selected from their four respective sources (CE0, CE1, CE2, CE3 and RST0, RST1, RST2, RST3) at each input register, pipeline register and output register.

Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

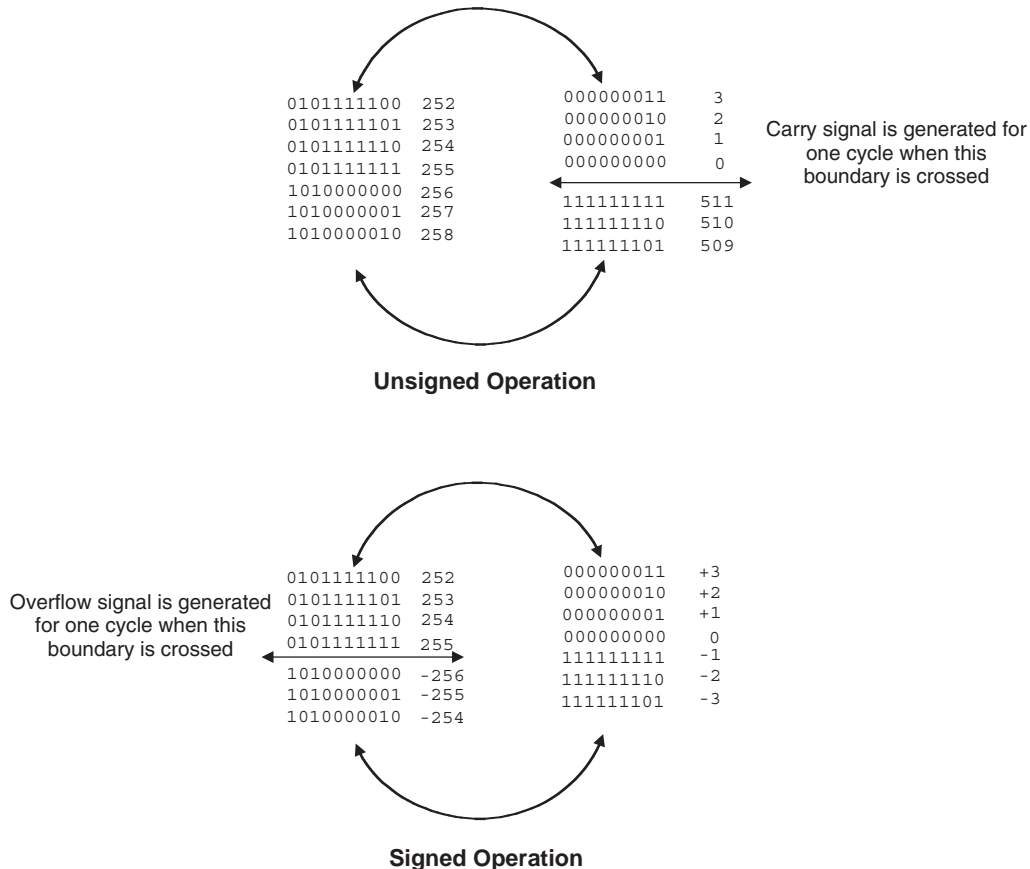
Table 2-8. Sign Extension Example

| Number | Unsigned | Unsigned 9-bit | Unsigned 18-bit | Signed | Two's Complement Signed 9 Bits | Two's Complement Signed 18 Bits |
|--------|----------|----------------|---------------------|--------|--------------------------------|---------------------------------|
| +5 | 0101 | 000000101 | 0000000000000000101 | 0101 | 000000101 | 0000000000000000101 |
| -6 | N/A | N/A | N/A | 1010 | 11111010 | 111111111111111010 |

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number than the accumulator, “roll-over” is said to have occurred and an overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator “roll-over” is said to have occurred and an overflow signal is indicated. Note that when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-27.

Figure 2-27. Accumulator Overflow/Underflow



IPexpress™

The user can access the sysDSP block via the IPexpress tool, which provides the option to configure each DSP module (or group of modules) or by direct HDL instantiation. In addition, Lattice has partnered with The MathWorks® to support instantiation in the Simulink® tool, a graphical simulation environment. Simulink works with Diamond to dramatically shorten the DSP design cycle in Lattice FPGAs.

Optimized DSP Functions

Lattice provides a library of optimized DSP IP functions. Some of the IP cores planned for the LatticeECP2/M DSP include the Bit Correlator, Fast Fourier Transform, Finite Impulse Response (FIR) Filter, Reed-Solomon Encoder/Decoder, Turbo Encoder/Decoder and Convolutional Encoder/Decoder. Please contact Lattice to obtain the latest list of available DSP IP cores.

Resources Available in the LatticeECP2/M Family

Table 2-9 shows the maximum number of multipliers for each member of the LatticeECP2/M family. Table 2-10 shows the maximum available EBR RAM Blocks in each LatticeECP2/M device. EBR blocks, together with Distributed RAM can be used to store variables locally for fast DSP operations.

Table 2-9. Maximum Number of DSP Blocks in the LatticeECP2/M Family

| Device | DSP Block | 9x9 Multiplier | 18x18 Multiplier | 36x36 Multiplier |
|----------|-----------|----------------|------------------|------------------|
| ECP2-6 | 3 | 24 | 12 | 3 |
| ECP2-12 | 6 | 48 | 24 | 6 |
| ECP2-20 | 7 | 56 | 28 | 7 |
| ECP2-35 | 8 | 64 | 32 | 8 |
| ECP2-50 | 18 | 144 | 72 | 18 |
| ECP2-70 | 22 | 176 | 88 | 22 |
| ECP2M20 | 6 | 48 | 24 | 6 |
| ECP2M35 | 8 | 64 | 32 | 8 |
| ECP2M50 | 22 | 176 | 88 | 22 |
| ECP2M70 | 24 | 192 | 96 | 24 |
| ECP2M100 | 42 | 336 | 168 | 42 |

Table 2-10. Embedded SRAM in the LatticeECP2/M Family

| Device | EBR SRAM Block | Total EBR SRAM (Kbits) |
|----------|----------------|------------------------|
| ECP2-6 | 3 | 55 |
| ECP2-12 | 12 | 221 |
| ECP2-20 | 15 | 277 |
| ECP2-35 | 18 | 332 |
| ECP2-50 | 21 | 387 |
| ECP2-70 | 60 | 1106 |
| ECP2M20 | 66 | 1217 |
| ECP2M35 | 114 | 2101 |
| ECP2M50 | 225 | 4147 |
| ECP2M70 | 246 | 4534 |
| ECP2M100 | 288 | 5308 |

LatticeECP2/M DSP Performance

Table 2-11 lists the maximum performance in millions of MAC operations per second (MMAC) for each member of the LatticeECP2/M family.

Table 2-11. DSP Performance

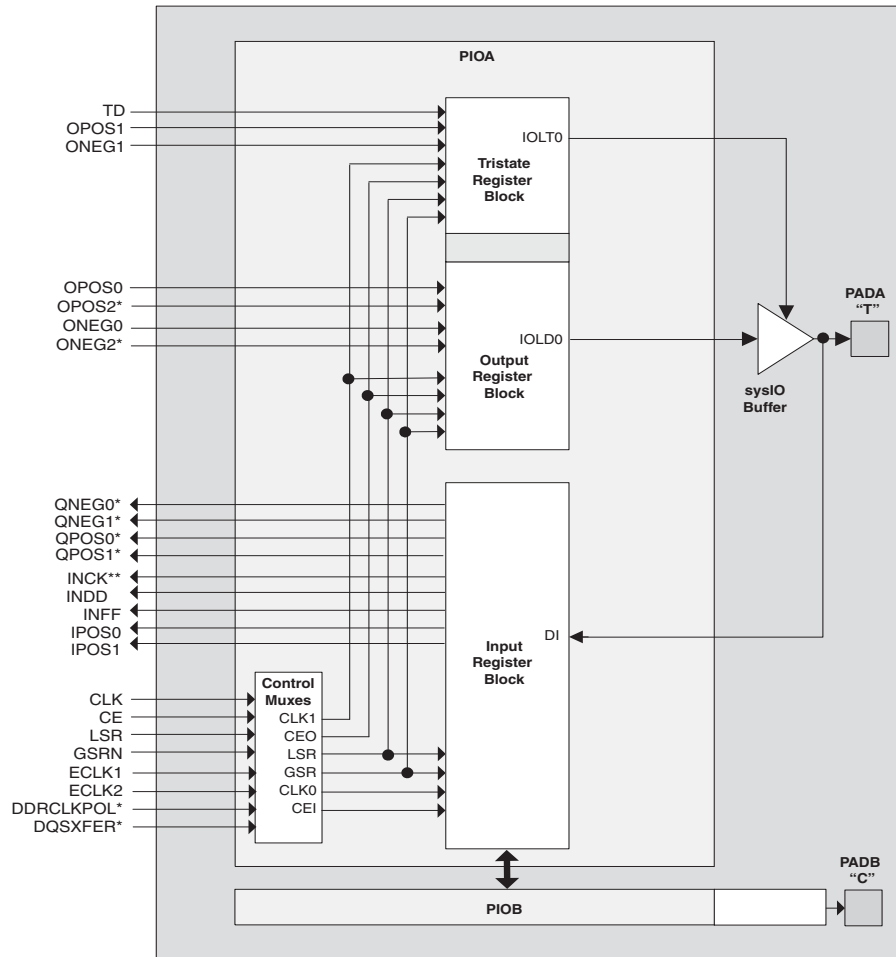
| Device | DSP Block | DSP Performance GMAC |
|----------|-----------|-------------------------|
| ECP2-6 | 3 | 3.9 |
| ECP2-12 | 6 | 7.8 |
| ECP2-20 | 7 | 9.1 |
| ECP2-35 | 8 | 10.4 |
| ECP2-50 | 18 | 23.4 |
| ECP2-70 | 22 | 28.6 |
| ECP2M20 | 6 | 7.8 |
| ECP2M35 | 8 | 10.4 |
| ECP2M50 | 22 | 28.6 |
| ECP2M70 | 24 | 31.2 |
| ECP2M100 | 42 | 54.6 |

For further information about the sysDSP block, please see the list of additional technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O buffers as shown in Figure 2-28. The PIO Block supplies the output data (DO) and the tri-state control signal (TO) to the sysI/O buffer and receives input from the buffer. Table 2-12 provides the PIO signal list.

Figure 2-28. PIC Diagram



*Signals are available on left/right/bottom edges only.
** Selected blocks.

Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-28. The PAD Labels “T” and “C” distinguish the two PIOs. Approximately 50% of the PIO pairs on the left and right edges of the device can be configured as true LVDS outputs. All I/O pairs can operate as inputs.

Table 2-12. PIO Signals List

| Name | Type | Description |
|---|---------------------------------|---|
| CE0, CE1 | Control from the core | Clock enables for input and output block flip-flops |
| CLK0, CLK1 | Control from the core | System clocks for input and output blocks |
| ECLK1, ECLK2 | Control from the core | Fast edge clocks |
| LSR | Control from the core | Local Set/Reset |
| GSRN | Control from routing | Global Set/Reset (active low) |
| INCK ² | Input to the core | Input to Primary Clock Network or PLL reference inputs |
| DQS | Input to PIO | DQS signal from logic (routing) to PIO |
| INDD | Input to the core | Unregistered data input to core |
| INFF | Input to the core | Registered input on positive edge of the clock (CLK0) |
| IPOS0, IPOS1 | Input to the core | Double data rate registered inputs to the core |
| QPOS0 ¹ , QPOS1 ¹ | Input to the core | Gearbox pipelined inputs to the core |
| QNEG0 ¹ , QNEG1 ¹ | Input to the core | Gearbox pipelined inputs to the core |
| OPOS0, ONEG0, OPOS2, ONEG2 | Output data from the core | Output signals from the core for SDR and DDR operation |
| OPOS1 ONEG1 | Tristate control from the core | Signals to Tristate Register block for DDR operation |
| DEL[3:0] | Control from the core | Dynamic input delay control bits |
| TD | Tristate control from the core | Tristate signal from the core used in SDR operation |
| DDRCLKPOL | Control from clock polarity bus | Controls the polarity of the clock (CLK0) that feed the DDR input block |
| DQSXFER | Control from core | Controls signal to the Output block |

1. Signals available on left/right/bottom only.

2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

Figure 2-29. Input Register Block for Left, Right and Bottom Edges

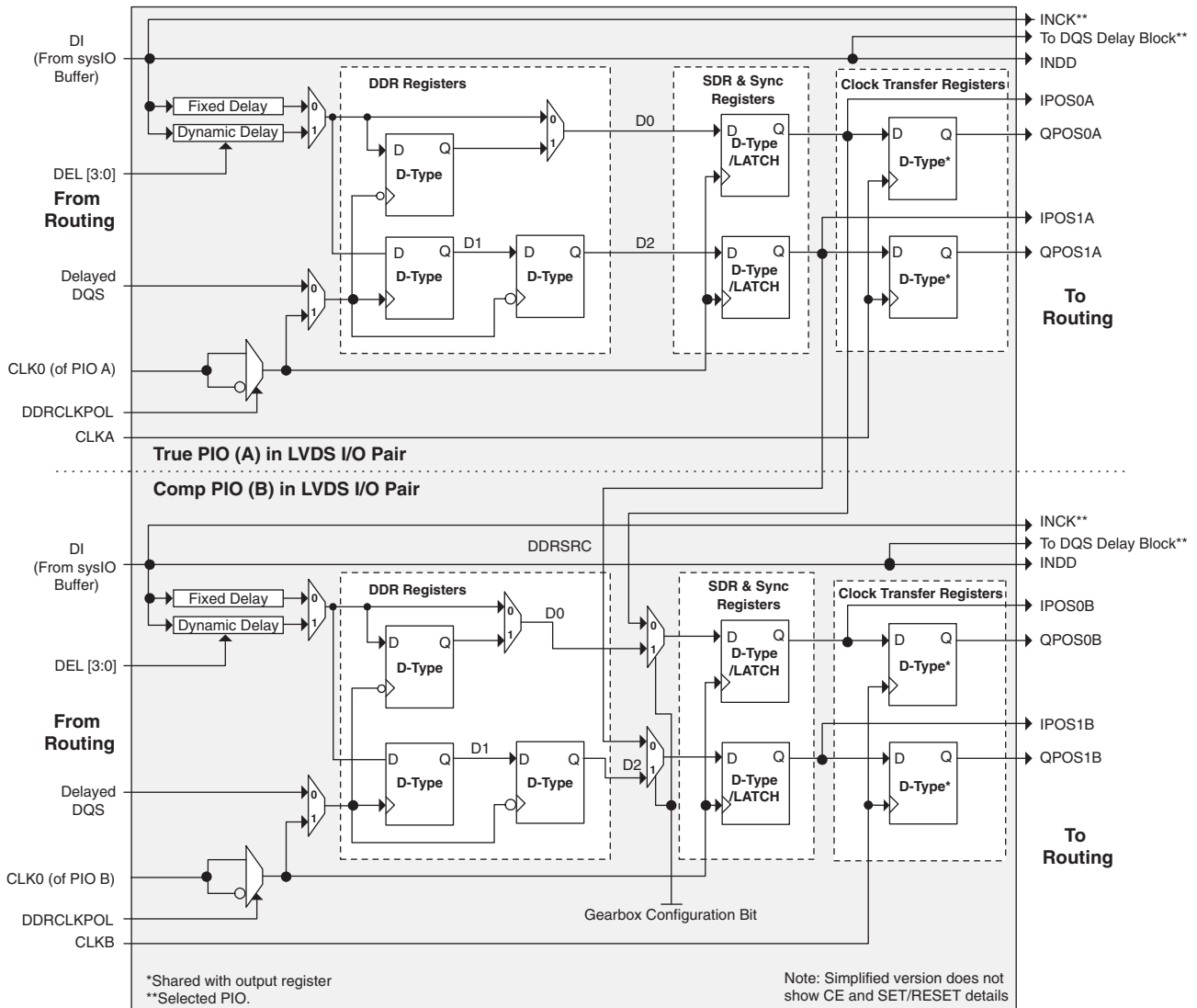
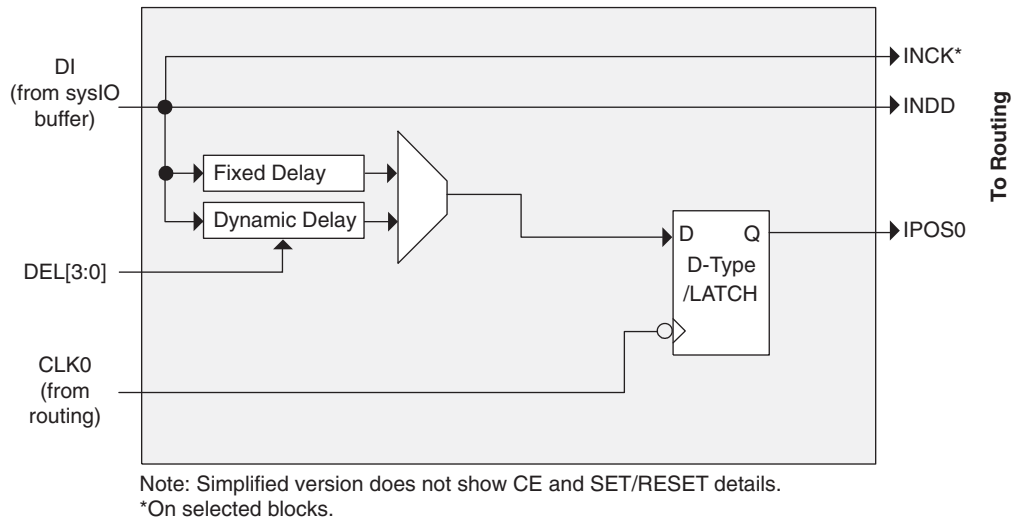


Figure 2-30. Input Register Block Top Edge



Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The blocks on the PIOs on the left, right and bottom contain a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-31 shows the diagram of the Output Register Block for PIOs on the left, right and the bottom edges. Figure 2-32 shows the diagram of the Output Register Block for PIOs on the top edge of the device.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured as a D-type or latch. In DDR mode, ONEG0 and OPOS0 are fed into registers on the positive edge of the clock. Then at the next clock cycle this registered OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

By combining the output blocks of the complementary PIOs and sharing some registers from input blocks, a gearbox function can be implemented, that takes four data streams: ONEG0A, ONEG1A, ONEG1B and ONEG1B. Figure 2-32 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

Figure 2-31. Output and Tristate Block for Left, Right and Bottom Edges

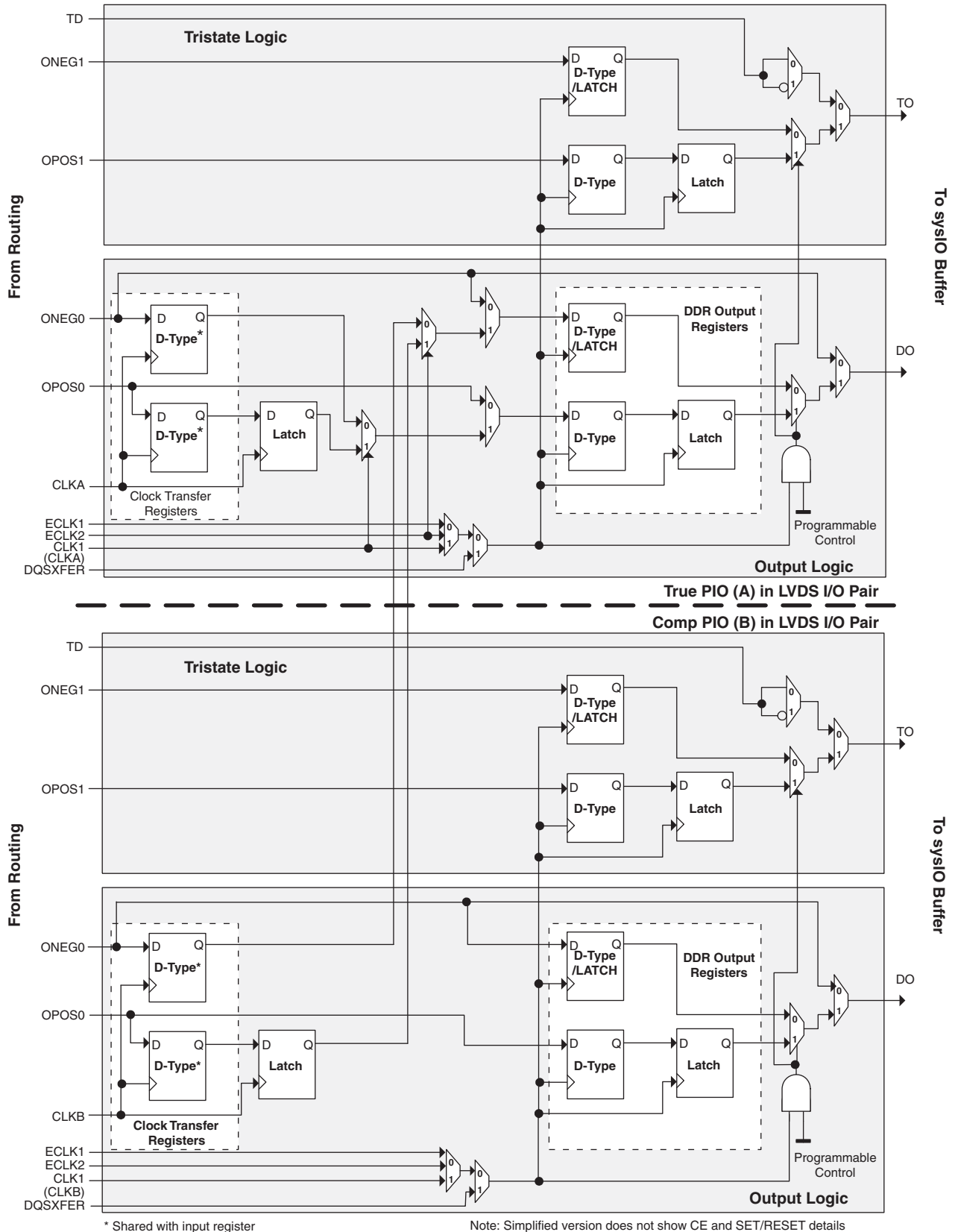
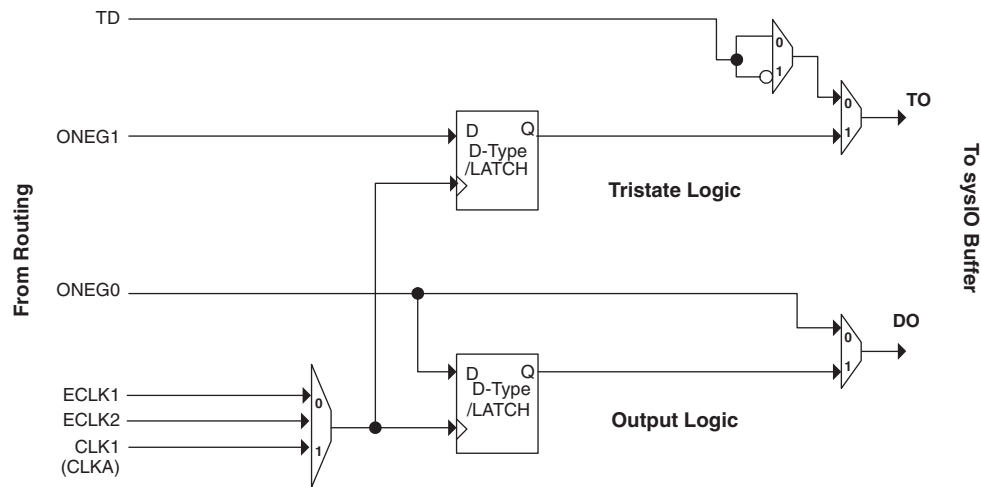


Figure 2-32. Output and Tristate Block, Top Edge



Note: Simplified version does not show CE and SET/RESET details.

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sys/O buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block with the Output Block for the left, right and bottom edges and Figure 2-32 shows the diagram of the Tristate Register Block with the Output Block for the top edge.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 and OPOS1 are fed into registers on the positive edge of the clock. Then in the next clock the registered OPOS1 is latched. A multiplexer running off the same clock cycle selects the correct register for feeding to the output (DO).

Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing, one of the edge clocks (ECLK1/ECLK2) and a DQS signal provided from the programmable DQS pin and provided to the input register block. The clock can optionally be inverted.

DDR Memory Support

Certain PICs have additional circuitry to allow the implementation of high speed source synchronous and DDR memory interfaces. The support varies by the edge of the device as detailed below.

Left and Right Edges

PICs on these edges have registered elements that support DDR memory interfaces. One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 16 PIOs. Figure 2-33 shows the assignment of DQS pins in each set of 16 PIOs.

Bottom Edge

PICs on the bottom edge have registered elements that support DDR memory interfaces. One of every 18 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 18 PIOs. Figure 2-34 shows the assignment of DQS pins in each set of 18 PIOs.

Top Edge

The PICs on the top edge are different from PIOs on the left, right and bottom edges. PIOs on this edge do not have DDR registers or DQS signals.

The exact DQS pins are shown in a dual function in the Logic Signal Connections table in this data sheet. Additional detail is provided in the Signal Descriptions table. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. Interfaces on the left and right edges are designed for DDR memories that support 16 bits of data, whereas interfaces on the bottom are designed for memories that support 18 bits of data.

Figure 2-33. DQS Input Routing for the Left and Right Edges of the Device

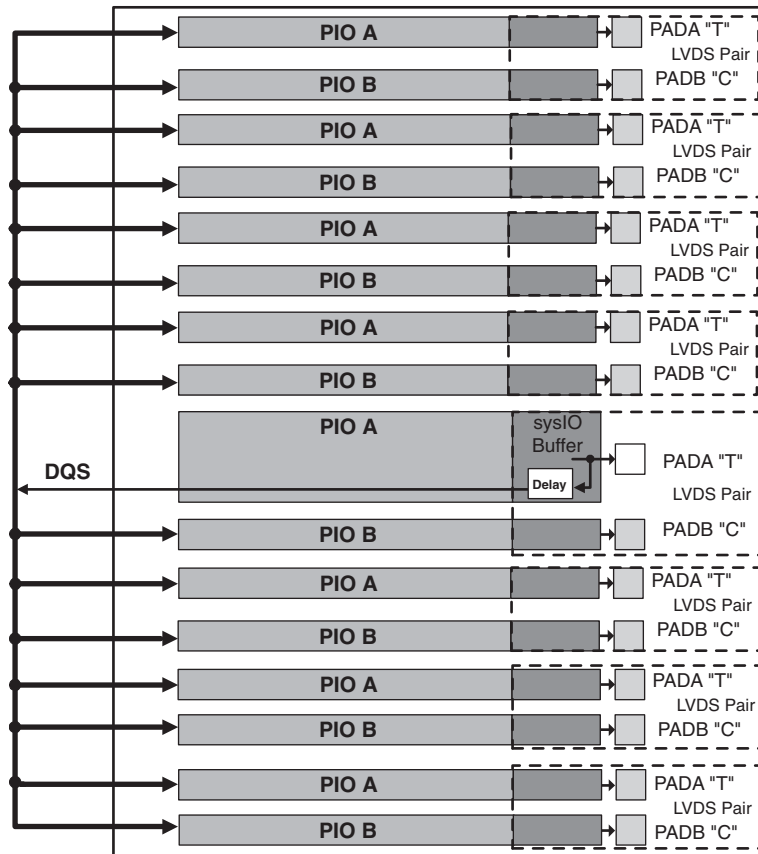
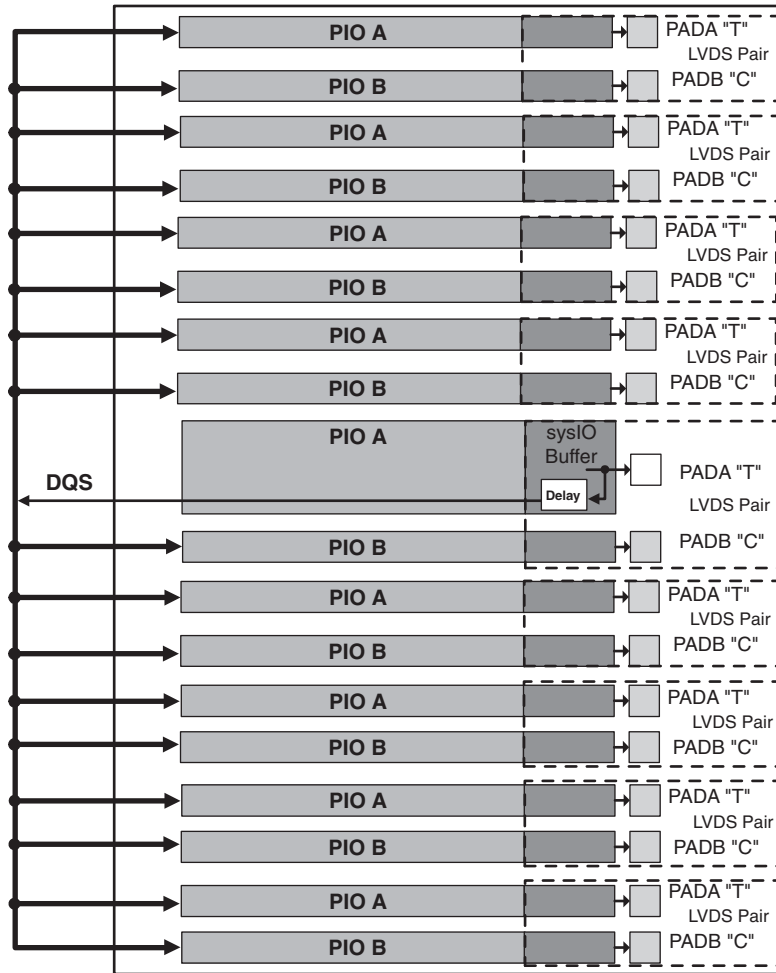


Figure 2-34. DQS Input Routing for the Bottom Edge of the Device



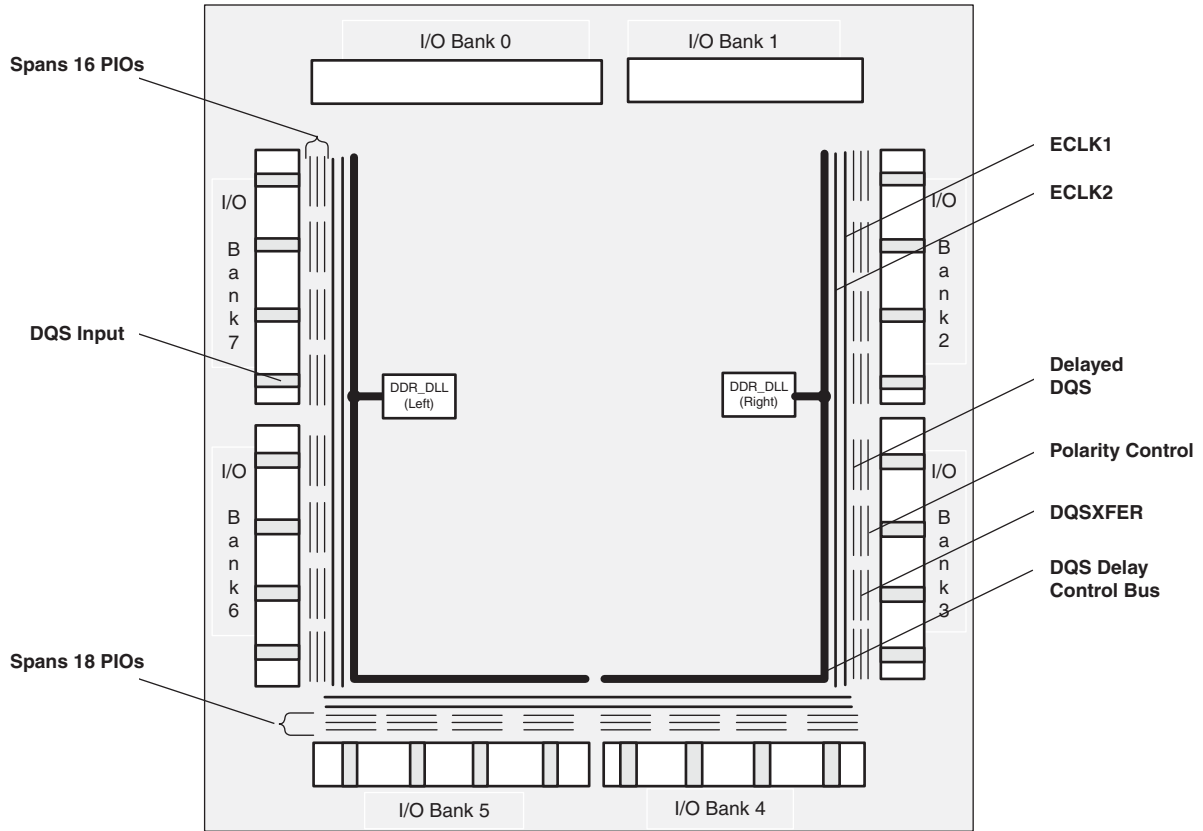
DLL Calibrated DQS Delay Block

Source synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However, in DDR memories the clock (referred to as DQS) is not free-running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only, as shown in Figure 2-35) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figure 2-35 and Figure 2-36 show how the DQS transition signals are routed to the PIOs.

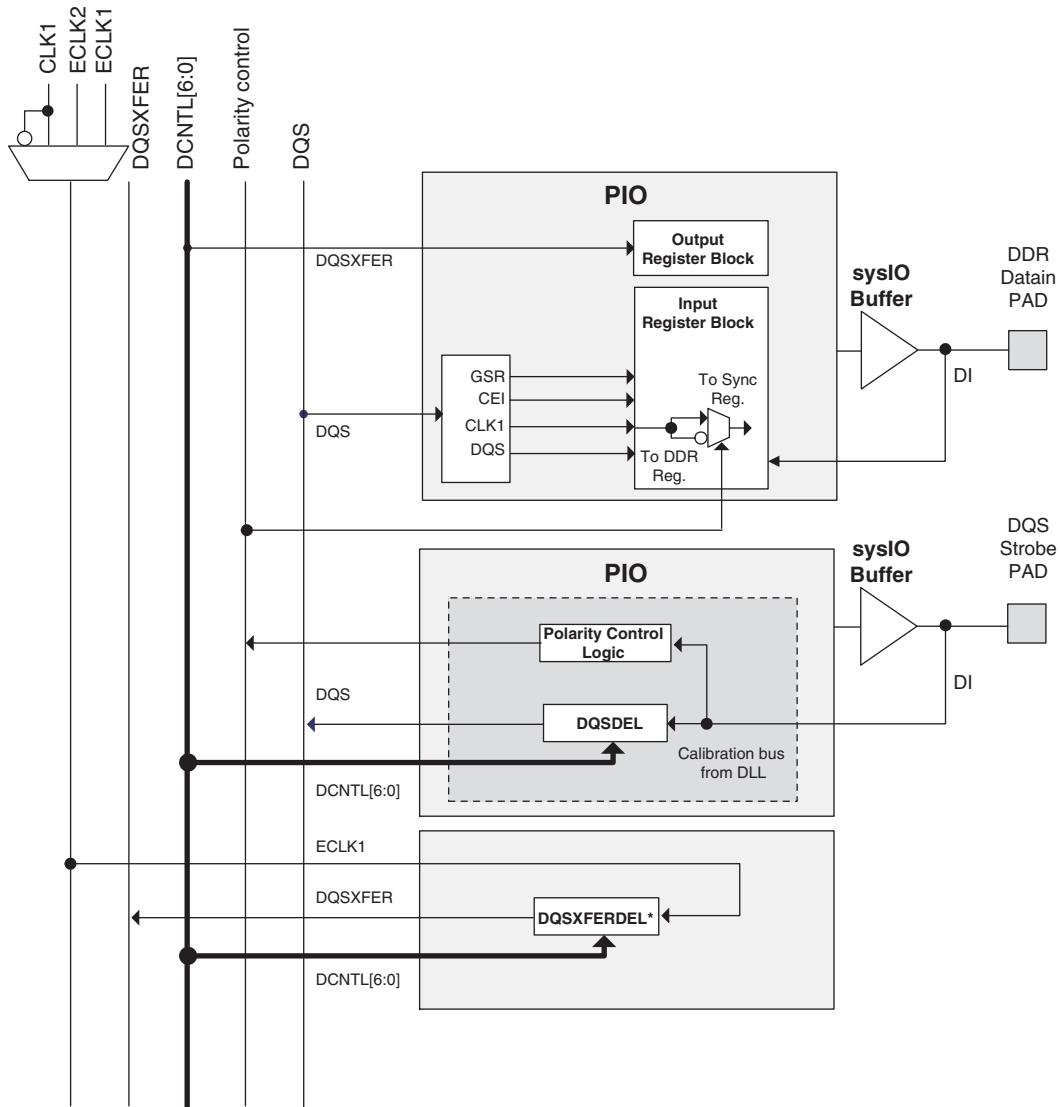
The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two dedicated DLLs (DDR_DLL) on opposite sides of the device. Each DLL compensates DQS delays in its half of the device as shown in Figure 2-35. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

Figure 2-35. Edge Clock, DLL Calibration and DQS Local Bus Distribution



Note: Bank 8 is not shown.

Figure 2-36. DQS Local Bus



*DQSXFERDEL shifts ECLK1 by 90% and is not associated with a particular PIO.

Polarity Control Logic

In a typical DDR Memory interface design, the phase relationship between the incoming delayed DQS strobe and the internal system clock (during the READ cycle) is unknown.

The LatticeECP2/M family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects the first DQS rising edge after the preamble state. This signal is used to control the polarity of the clock to the synchronizing registers.

DQSXFER

LatticeECP2/M devices provide a DQSXFER signal to the output buffer to assist it in data transfer to DDR memories that require DQS strobe be shifted 90°. This shifted DQS strobe is generated by the DQSDEL block. The DQSXFER signal runs the span of the data bus.

sysI/O Buffer

Each I/O is associated with a flexible buffer referred to as a sysI/O buffer. These buffers are arranged around the periphery of the device in groups referred to as banks. The sysI/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL.

sysI/O Buffer Banks

LatticeECP2/M devices have nine sysI/O buffer banks: eight banks for user I/Os arranged two per side. The ninth sysI/O buffer bank (Bank 8) is located adjacent to Bank 3 and has dedicated/shared I/Os for configuration. When a shared pin is not used for configuration it is available as a user I/O. Each bank is capable of supporting multiple I/O standards. Each sysI/O bank has its own I/O supply voltage (V_{CCIO}). In addition, each bank, except Bank 8, has voltage references, V_{REF1} and V_{REF2} , which allow it to be completely independent from the others. Bank 8 shares two voltage references, V_{REF1} and V_{REF2} , with Bank 3. Figure 2-37 shows the nine banks and their associated supplies.

In LatticeECP2/M devices, single-ended output buffers and ratioed input buffers (LVTTL, LVCMOS and PCI) are powered using V_{CCIO} . LVTTL, LVCMOS33, LVCMOS25 and LVCMOS12 can also be set as fixed threshold inputs independent of V_{CCIO} .

Each bank can support up to two separate V_{REF} voltages, V_{REF1} and V_{REF2} , that set the threshold for the referenced input buffers. Some dedicated I/O pins in a bank can be configured to be a reference voltage supply pin. Each I/O is individually configurable based on the bank's supply and reference voltages.

Figure 2-37. LatticeECP2 Banks

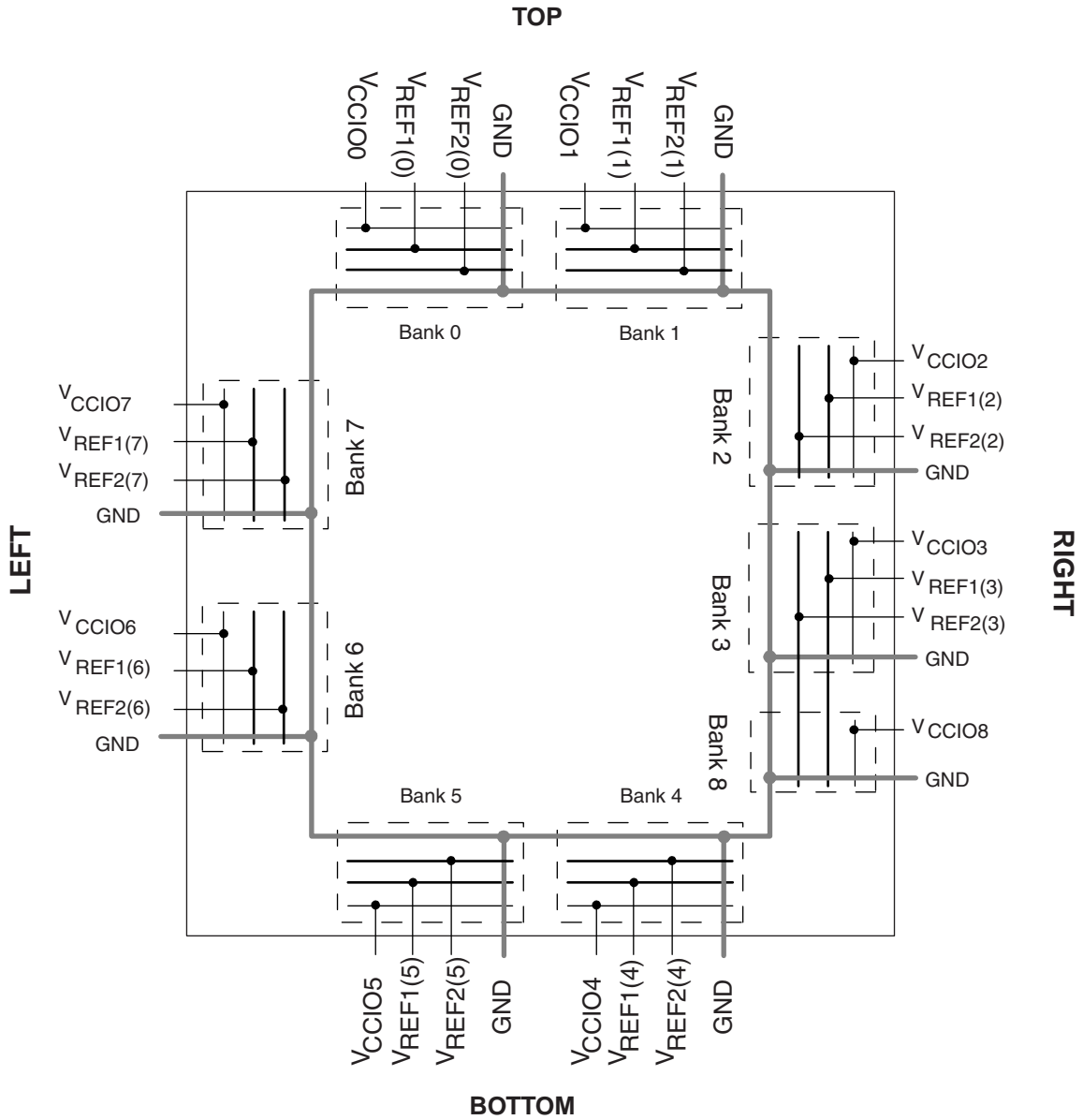
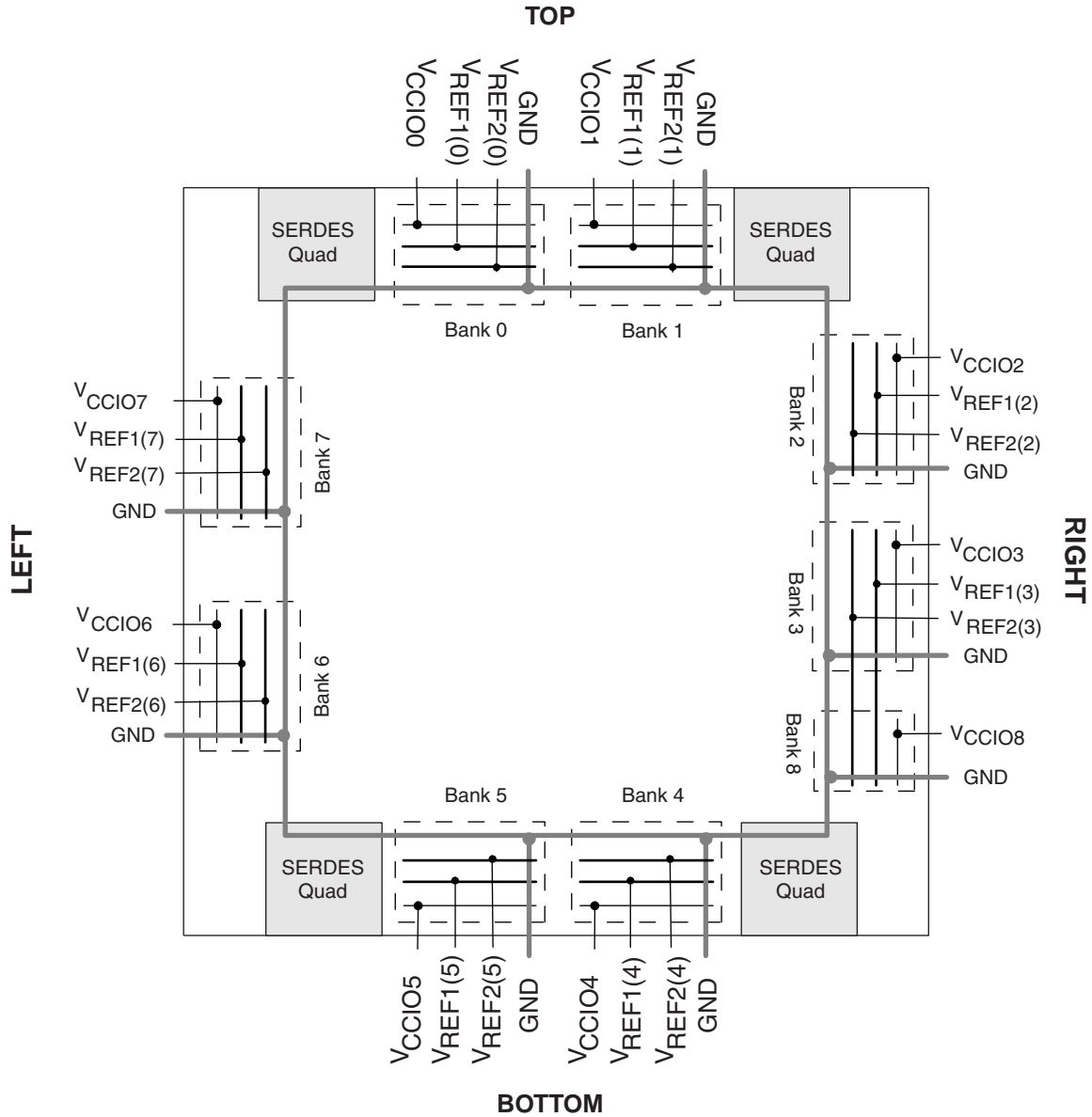


Figure 2-38. LatticeECP2M Banks



LatticeECP2/M devices contain two types of sysI/O buffer pairs.

1. **Top (Bank 0 and Bank 1) sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the top banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

2. **Bottom (Bank 4 and Bank 5) sysI/O Buffer Pairs (Single-Ended Outputs Only)**

The sysI/O buffer pairs in the bottom banks of the device consist of two single-ended output drivers and two

sets of single-ended input buffers (both ratioed and referenced). One of the referenced input buffers can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

3. Left and Right (Banks 2, 3, 6 and 7) sys/I/O Buffer Pairs (50% Differential and 100% Single-Ended Outputs)

The sys/I/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. One of the referenced input buffers can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

LVDS differential output drivers are available on 50% of the buffer pairs on the left and right banks.

4. Bank 8 sys/I/O Buffer Pairs (Single-Ended Outputs, Only on Shared Pins When Not Used by Configuration)

The sys/I/O buffers in Bank 8 consist of single-ended output drivers and single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

In LatticeECP2 devices, only the I/Os on the bottom banks have programmable PCI clamps. In LatticeECP2M devices, the I/Os on the left and bottom banks have programmable PCI clamps.

Typical sys/I/O I/O Behavior During Power-up

The internal power-on-reset (POR) signal is deactivated when V_{CC} , V_{CCIO8} and V_{CCAUX} have reached satisfactory levels. After the POR signal is deactivated, the FPGA core logic becomes active. It is the user's responsibility to ensure that all other V_{CCIO} banks are active with valid input logic levels to properly control the output logic states of all the I/O banks that are critical to the application. For more information about controlling the output logic state with valid input logic levels during power-up in LatticeECP2/M devices, see the list of additional technical documentation at the end of this data sheet.

The V_{CC} and V_{CCAUX} supply the power to the FPGA core fabric, whereas the V_{CCIO} supplies power to the I/O buffers. In order to simplify system design while providing consistent and predictable I/O behavior, it is recommended that the I/O buffers be powered-up prior to the FPGA core fabric. V_{CCIO} supplies should be powered-up before or together with the V_{CC} and V_{CCAUX} supplies.

Prior to and throughout programming of the FPGA, the I/O of the device have a weak-pullup resistor to V_{CCIO} on the input buffer and the output buffer is tri-stated. A pullup to V_{CCIO} is present on the input until the user programs the input differently in the FPGA design. See the [DC Electrical Characteristics](#) table of this data sheet. The pullup value will be between 20-30K ohms based on the V_{CCIO} voltage supplied on the board. This pullup will also remain active if the design does not use a particular I/O.

Supported sys/I/O Standards

The LatticeECP2/M sys/I/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVCMOS, LVTTTL and other standards. The buffers support the LVTTTL, LVCMOS 1.2V, 1.5V, 1.8V, 2.5V and 3.3V standards. In the LVCMOS and LVTTTL modes, the buffer has individual configuration options for drive strength, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL and HSTL. Differential standards supported include LVDS, MLVDS, BLVDS, LVPECL, RSDS, differential SSTL and differential HSTL. Tables 2-13 and 2-14 show the I/

O standards (together with their supply and reference voltages) supported by LatticeECP2/M devices. For further information about utilizing the sysI/O buffer to support a variety of standards please see the the list of additional technical information at the end of this data sheet.

Table 2-13. Supported Input Standards

| Input Standard | V _{REF} (Nom.) | V _{CCIO} ¹ (Nom.) |
|----------------------------------|-------------------------|---------------------------------------|
| Single Ended Interfaces | | |
| LVTTTL | — | — |
| LVC MOS33 | — | — |
| LVC MOS25 | — | — |
| LVC MOS18 | — | 1.8 |
| LVC MOS15 | — | 1.5 |
| LVC MOS12 | — | — |
| PCI 33 | — | 3.3 |
| HSTL18 Class I, II | 0.9 | — |
| HSTL15 Class I | 0.75 | — |
| SSTL3 Class I, II | 1.5 | — |
| SSTL2 Class I, II | 1.25 | — |
| SSTL18 Class I, II | 0.9 | — |
| Differential Interfaces | | |
| Differential SSTL18 Class I, II | — | — |
| Differential SSTL2 Class I, II | — | — |
| Differential SSTL3 Class I, II | — | — |
| Differential HSTL15 Class I | — | — |
| Differential HSTL18 Class I, II | — | — |
| LVDS, MLVDS, LVPECL, BLVDS, RSDS | — | — |

¹ When not specified, V_{CCIO} can be set anywhere in the valid operating range (page 3-1).

Table 2-14. Supported Output Standards

| Output Standard | Drive | V _{CCIO} (Nom.) |
|----------------------------------|----------------------------|--------------------------|
| Single-ended Interfaces | | |
| LVTTTL | 4mA, 8mA, 12mA, 16mA, 20mA | 3.3 |
| LVC MOS33 | 4mA, 8mA, 12mA 16mA, 20mA | 3.3 |
| LVC MOS25 | 4mA, 8mA, 12mA, 16mA, 20mA | 2.5 |
| LVC MOS18 | 4mA, 8mA, 12mA, 16mA | 1.8 |
| LVC MOS15 | 4mA, 8mA | 1.5 |
| LVC MOS12 | 2mA, 6mA | 1.2 |
| LVC MOS33, Open Drain | 4mA, 8mA, 12mA 16mA, 20mA | — |
| LVC MOS25, Open Drain | 4mA, 8mA, 12mA 16mA, 20mA | — |
| LVC MOS18, Open Drain | 4mA, 8mA, 12mA 16mA | — |
| LVC MOS15, Open Drain | 4mA, 8mA | — |
| LVC MOS12, Open Drain | 2mA, 6mA | — |
| PCI33 | N/A | 3.3 |
| HSTL18 Class I, II | N/A | 1.8 |
| HSTL15 Class I | N/A | 1.5 |
| SSTL3 Class I, II | N/A | 3.3 |
| SSTL2 Class I, II | N/A | 2.5 |
| SSTL18 Class I, II | N/A | 1.8 |
| Differential Interfaces | | |
| Differential SSTL3, Class I, II | N/A | 3.3 |
| Differential SSTL2, Class I, II | N/A | 2.5 |
| Differential SSTL18, Class I, II | N/A | 1.8 |
| Differential HSTL18, Class I, II | N/A | 1.8 |
| Differential HSTL15, Class I | N/A | 1.5 |
| LVDS | N/A | 2.5 |
| MLVDS ¹ | N/A | 2.5 |
| BLVDS ¹ | N/A | 2.5 |
| LVPECL ¹ | N/A | 3.3 |
| RSDS ¹ | N/A | 2.5 |
| LVC MOS33D ¹ | 4mA, 8mA, 12mA, 16mA, 20mA | 3.3 |

1. Emulated with external resistors. For more detail, please see information regarding additional technical documentation at the end of this data sheet.

Hot Socketing

LatticeECP2/M devices have been carefully designed to ensure predictable behavior during power-up and power-down. During power-up and power-down sequences, the I/Os remain in tri-state until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits. This allows for easy integration with the rest of the system. These capabilities make the LatticeECP2/M ideal for many multiple power supply and hot-swap applications.

SERDES and PCS (Physical Coding Sublayer)

LatticeECP2M devices feature up to 16 channels of embedded SERDES arranged in quads at the corners of the devices. Figure 2-39 shows the position of the quad blocks in relation to the PFU array for LatticeECP2M70 and LatticeECP2M100 devices. Table 2-15 shows the location of Quads for all the devices.

Each quad contains four dedicated SERDES (Ch0 to Ch3) for high-speed, full-duplex serial data transfer. Each quad also has a PCS block that interfaces to the SERDES channels and contains digital logic to support an array of popular data protocols. PCS also contains logic to the interface to FPGA core.

Figure 2-39. SERDES Quads (LatticeECP2M70/LatticeECP2M100)

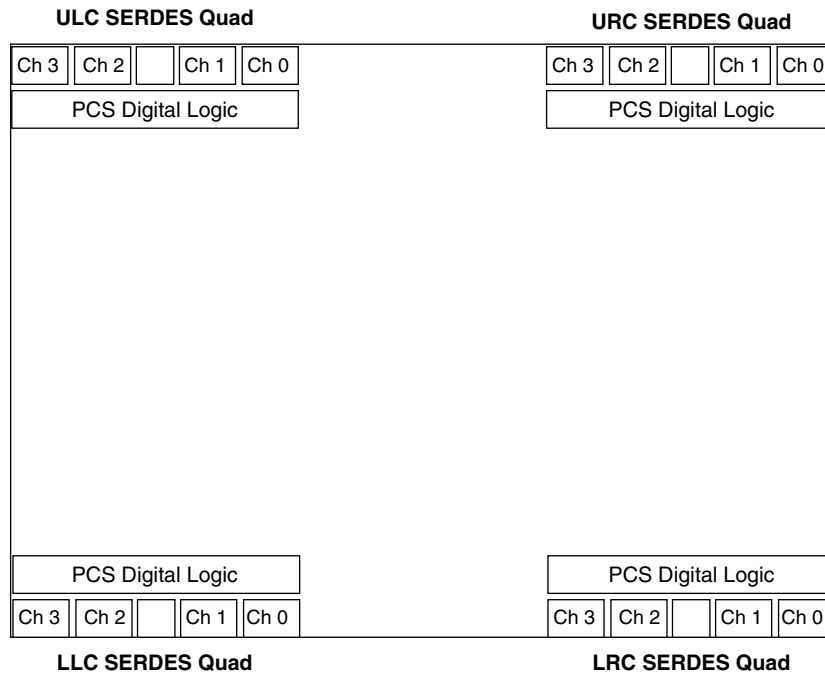


Table 2-15. Available SERDES Quads per LatticeECP2M Devices

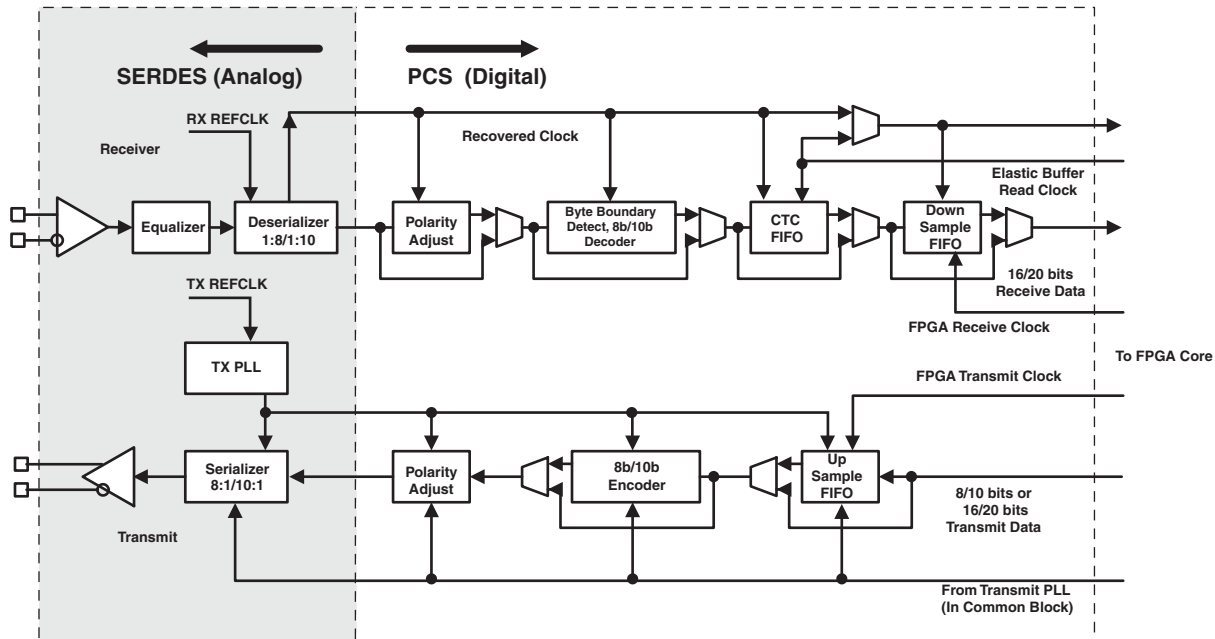
| Device | URC Quad | ULC Quad | LRC Quad | LLC Quad |
|----------|-----------|-----------|-----------|-----------|
| ECP2M20 | Available | — | — | — |
| ECP2M35 | Available | — | — | — |
| ECP2M50 | Available | — | Available | — |
| ECP2M70 | Available | Available | Available | Available |
| ECP2M100 | Available | Available | Available | Available |

SERDES Block

A differential receiver receives the serial encoded data stream, equalizes the signal, extracts the buried clock and de-serializes the data-stream before passing the 8- or 10-bit data to the PCS logic. The transmit channel receives the parallel (8- or 10-bit) encoded data, serializes the data and transmits the serial bit stream through the differential buffers. There is a single transmit clock per quad. Figure 2-40 shows a single channel SERDES and its interface to the PCS logic. Each SERDES receiver channel provides a recovered clock to the PCS block and to the FPGA core logic.

Each Transmit and Receive channel has its independent power supplies. The Output and Input buffers of each channel also have their own independent power supplies. In addition, there are separate power supplies for PLL, terminating resistor per quad.

Figure 2-40. Simplified Channel Block Diagram for SERDES and PCS



PCS

As shown in Figure 2-40, the PCS receives the parallel digital data from the deserializer receivers and adjusts the polarity, detects, byte boundary, decodes (8b/10b) and provides Clock Tolerance Compensation (CTC) FIFO for changing the clock domain from receiver clock to the FPGA Clock.

For the transmit channel, the PCS block receives the parallel data from the FPGA core, encodes it with 8b/10b, adjusts the polarity and passes the 8/10 bit data to the transmit SERDES channel.

The PCS also provides bypass modes that allow a direct 8-bit or 10-bit interface from the SERDES to the FPGA logic. The PCS interface to FPGA can also be programmed to run at 1/2 speed for a 16-bit or 20-bit interface to the FPGA logic.

SCI (SERDES Client Interface) Bus

The SERDES Client Interface (SCI) is a soft IP interface that allow the SERDES/PCS Quad block to be controlled by registers as opposed to the configuration memory cells. It is a simple register configuration interface.

The Diamond design tools support all modes of the PCS. Most modes are dedicated to applications associated with a specific industry standard data protocol. Other more general purpose modes allow users to define their own operation. With Diamond, the user can define the mode for each quad in a design.

Popular standards such as 10Gb Ethernet and x4 PCI-Express and 4x Serial RapidIO can be implemented using IP (provided by Lattice), a single quad (Four SERDES channels and PCS) and some additional logic from the core.

For further information about SERDES, please see the list of additional technical documentation at the end of this data sheet.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP2/M devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant Test Access Port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP2/M devices contain two ports that can be used for device configuration. The Test Access Port (TAP), which supports bit-wide configuration, and the sysCONFIG port, support both byte-wide and serial configuration, including the standard SPI Flash interface. The TAP supports both the IEEE Standard 1149.1 Boundary Scan specification and the IEEE Standard 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six I/Os used as dedicated pins with the remainder used as dual-use pins. See TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#) for more information about using the dual-use pins as general purpose I/Os.

On power-up, the FPGA SRAM is ready to be configured using the selected sysCONFIG port. Once a configuration port is selected, it will remain active throughout that configuration cycle. The IEEE 1149.1 port can be activated any time after power-up by sending the appropriate command through the TAP port.

Enhanced Configuration Option

LatticeECP2/M devices have enhanced configuration features such as: decryption support, TransFR™ I/O and dual boot image support.

1. Decryption Support

LatticeECP2/M devices provide on-chip, One Time Programmable (OTP) non-volatile key storage to support decryption of a 128-bit AES encrypted bitstream, securing designs and deterring design piracy.

2. TransFR (Transparent Field Reconfiguration)

TransFR I/O (TFR) is a unique Lattice technology that allows users to update their logic in the field without interrupting system operation using a single ispVM® command. TransFR I/O allows I/O states to be frozen during device configuration. This allows the device to be field updated with a minimum of system disruption and downtime. See TN1087, [Minimizing System Interruption During Configuration Using TransFR Technology](#), for details.

3. Dual Boot Image Support

Dual boot images are supported for applications requiring reliable remote updates of configuration data for the system FPGA. After the system is running with a basic configuration, a new boot image can be downloaded remotely and stored in a separate location in the configuration storage device. Any time after the update the LatticeECP2/M can be re-booted from this new configuration file. If there is a problem, such as corrupt data during download or incorrect version number with this new boot image, the LatticeECP2/M device can revert back to the original backup configuration and try again. This all can be done without power cycling the system.

For more information about device configuration, please see the list of additional technical documentation at the end of this data sheet.

Soft Error Detect (SED) Support

LatticeECP2/M devices have dedicated logic to perform CRC checks. During configuration, the configuration data bitstream can be checked with the CRC logic block. In addition, the LatticeECP2 device can also be programmed

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm $\pm 1\%$ value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

| Non-Encrypted Mode CCLK (MHz) | | | Encrypted Mode CCLK (MHz) |
|-------------------------------|------|-------|---------------------------|
| 2.5 ¹ | 13.0 | 45.0 | 2.5 ¹ |
| 4.3 | 15.0 | 55.0 | 5.4 |
| 5.4 | 20.0 | 60.0 | 10.0 |
| 6.9 | 26.0 | — | 34.0 |
| 8.1 | 30.0 | — | 41.0 |
| 9.2 | 34.0 | — | 45.0 |
| 10.0 | 41.0 | 130.0 | — |

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

Absolute Maximum Ratings^{1, 2, 3}

| | |
|--|---------------|
| Supply Voltage V_{CC} | -0.5 to 1.32V |
| Supply Voltage V_{CCAUX} | -0.5 to 3.75V |
| Supply Voltage V_{CCJ} | -0.5 to 3.75V |
| Output Supply Voltage V_{CCIO} | -0.5 to 3.75V |
| Input or I/O Tristate Voltage Applied ⁴ | -0.5 to 3.75V |
| Storage Temperature (Ambient) | -65 to 150°C |
| Junction Temperature (Tj) | +125°C |

1. Stress above those listed under the “Absolute Maximum Ratings” may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to ($V_{IHMAX} + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions⁷

| Symbol | Parameter | Min. | Max. | Units |
|--|---|-------|-------|-------|
| $V_{CC}^{1,4,5}$ | Core Supply Voltage | 1.14 | 1.26 | V |
| $V_{CCAUX}^{1,3,4,5}$ | Auxiliary Supply Voltage | 3.135 | 3.465 | V |
| V_{CCPLL} | PLL Supply Voltage | 1.14 | 1.26 | V |
| $V_{CCIO}^{1,2,4}$ | I/O Driver Supply Voltage | 1.14 | 3.465 | V |
| V_{CCJ}^1 | Supply Voltage for IEEE 1149.1 Test Access Port | 1.14 | 3.465 | V |
| t_{JCOM} | Junction Temperature, Commercial Operation | 0 | 85 | °C |
| t_{JIND} | Junction Temperature, Industrial Operation | -40 | 100 | °C |
| SERDES External Power Supply (For LatticeECP2M Family Only) | | | | |
| V_{CCIB} | Input Buffer Power Supply (1.2V) | 1.14 | 1.26 | V |
| | Input Buffer Power Supply (1.5V) | 1.425 | 1.575 | V |
| V_{CCOB} | Output Buffer Power Supply (1.2V) | 1.14 | 1.26 | V |
| | Output Buffer Power Supply (1.5V) | 1.425 | 1.575 | V |
| $V_{CCAUX33}$ | Termination Resistor Switching Power Supply | 3.135 | 3.465 | V |
| $V_{CCR\!X}^6$ | Receive Power Supply | 1.14 | 1.26 | V |
| $V_{CCT\!X}^6$ | Transmit Power Supply | 1.14 | 1.26 | V |

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| Symbol | Parameter | Min. | Max. | Units |
|-------------|--------------------------------------|------|------|-------|
| V_{CCP}^6 | PLL and Reference Clock Buffer Power | 1.14 | 1.26 | V |

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} . V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/ μ s during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC} , V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8} , the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of V_{CC} or V_{CCAUX} reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M "S" version devices only).
6. V_{CCRX} , V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 [Electrical Recommendations for Lattice SERDES](#).

Hot Socketing Specifications^{1, 2, 3, 4}

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|--------------|--|------------------------------------|------|------|---------|---------|
| I_{DK} | Input or I/O leakage current | $0 \leq V_{IN} \leq V_{IH} (MAX.)$ | — | — | +/-1000 | μ A |
| I_{HDIN}^5 | SERDES average input current when device is powered down and inputs are driven | | — | — | 4 | mA |

1. V_{CC} , V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \leq V_{CC} \leq V_{CC} (MAX)$, $0 \leq V_{CCIO} \leq V_{CCIO} (MAX)$ or $0 \leq V_{CCAUX} \leq V_{CCAUX} (MAX)$.
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to [LatticeECP2/M Product Family Qualification Summary](#) for complete qualification data, including ESD performance.

DC Electrical Characteristics

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|------------------------|----------------------------------|--|----------------|------|----------------|---------|
| $I_{IL}, I_{IH}^{1,2}$ | Input or I/O Low Leakage | $0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$ | — | — | 10 | μA |
| $I_{IH}^{1,3}$ | Input or I/O High Leakage | $(V_{CCIO} - 0.2V) < V_{IN} \leq 3.6V$ | — | — | 150 | μA |
| I_{PU} | I/O Active Pull-up Current | $0 \leq V_{IN} \leq 0.7 V_{CCIO}$ | -30 | — | -210 | μA |
| I_{PD} | I/O Active Pull-down Current | $V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$ | 30 | — | 210 | μA |
| I_{BHLS} | Bus Hold Low Sustaining Current | $V_{IN} = V_{IL} (MAX)$ | 30 | — | — | μA |
| I_{BHHS} | Bus Hold High Sustaining Current | $V_{IN} = 0.7 V_{CCIO}$ | -30 | — | — | μA |
| I_{BHLO} | Bus Hold Low Overdrive Current | $0 \leq V_{IN} \leq V_{CCIO}$ | — | — | 210 | μA |
| I_{BHHO} | Bus Hold High Overdrive Current | $0 \leq V_{IN} \leq V_{CCIO}$ | — | — | -210 | μA |
| V_{BHT} | Bus Hold Trip Points | $0 \leq V_{IN} \leq V_{IH} (MAX)$ | $V_{IL} (MAX)$ | — | $V_{IH} (MIN)$ | V |
| $C1^4$ | I/O Capacitance | $V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | — | 5 | 8 | pf |
| $C2^4$ | Dedicated Input Capacitance | $V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$ | — | 5 | 6 | pf |

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. When used as V_{REF} maximum leakage = 25 μA
3. Applicable to general purpose I/Os in top and bottom banks.
4. T_A 25°C, $f = 1.0MHz$.

LatticeECP2 Supply Current (Standby)^{1, 2, 3, 4}**Over Recommended Operating Conditions**

| Symbol | Parameter | Device | Typ. ⁵ | Units |
|--------------|--------------------------------------|------------------------|-------------------|-------|
| I_{CC} | Core Power Supply Current | ECP2-6 | 10 | mA |
| | | ECP2-12 | 20 | mA |
| | | ECP2-20 | 30 | mA |
| | | ECP2-35 | 50 | mA |
| | | ECP2-50 | 70 | mA |
| | | ECP2-70 | 100 | mA |
| I_{CCAUX} | Auxiliary Power Supply Current | ECP2-6 | 24 | mA |
| | | ECP2-12 | 24 | mA |
| | | ECP2-20 | 24 | mA |
| | | ECP2-35 | 24 | mA |
| | | ECP2-50 | 24 | mA |
| | | ECP2-70 | 24 | mA |
| I_{CCGPLL} | GPLL Power Supply Current (per GPLL) | ECP2-35, -50, -70 Only | 0.5 | mA |
| I_{CCSPLL} | GPLL Power Supply Current (per SPLL) | ECP2-35, -50, -70 Only | 0.5 | mA |
| I_{CCIO} | Bank Power Supply Current (Per Bank) | ECP2-6 | 2 | mA |
| | | ECP2-12 | 2 | mA |
| | | ECP2-20 | 2 | mA |
| | | ECP2-35 | 2 | mA |
| | | ECP2-50 | 2 | mA |
| | | ECP2-70 | 2 | mA |
| I_{CCJ} | VCCJ Power Supply Current | All Devices | 3 | mA |

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J = 25^\circ\text{C}$, power supplies at normal voltage.

LatticeECP2M Supply Current (Standby)^{1, 2, 3, 4}

Over Recommended Operating Conditions

| Symbol | Parameter | Device | Typ. ⁵ | Units |
|--------------|--------------------------------------|-------------|-------------------|-------|
| I_{CC} | Core Power Supply Current | ECP2M20 | 25 | mA |
| | | ECP2M35 | 50 | mA |
| | | ECP2M50 | 85 | mA |
| | | ECP2M70 | 100 | mA |
| | | ECP2M100 | 100 | mA |
| I_{CCAUX} | Auxiliary Power Supply Current | ECP2M20 | 24 | mA |
| | | ECP2M35 | 24 | mA |
| | | ECP2M50 | 24 | mA |
| | | ECP2M70 | 24 | mA |
| | | ECP2M100 | 24 | mA |
| I_{CCGPLL} | GPLL Power Supply Current (per GPLL) | All Devices | 0.5 | mA |
| I_{CCSPLL} | GPLL Power Supply Current (per SPLL) | All Devices | 0.5 | mA |
| I_{CCIO} | Bank Power Supply Current (Per Bank) | ECP2M20 | 2 | mA |
| | | ECP2M35 | 2 | mA |
| | | ECP2M50 | 2 | mA |
| | | ECP2M70 | 2 | mA |
| | | ECP2M100 | 2 | mA |
| I_{CCJ} | V_{CCJ} Power Supply Current | All Devices | 3 | mA |

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J = 25^\circ\text{C}$, power supplies at normal voltage.

LatticeECP2 Initialization Supply Current^{1, 2, 3, 4}**Over Recommended Operating Conditions**

| Symbol | Parameter | Device | Typ. ^{5, 6, 7} | Units |
|--------------|--------------------------------------|------------------------|-------------------------|-------|
| I_{CC} | Core Power Supply Current | ECP2-6 | 34 | mA |
| | | ECP2-12 | 54 | mA |
| | | ECP2-20 | 82 | mA |
| | | ECP2-35 | 135 | mA |
| | | ECP2-50 | 187 | mA |
| | | ECP2-70 | 267 | mA |
| I_{CCAUX} | Auxiliary Power Supply Current | ECP2-6 | 30 | mA |
| | | ECP2-12 | 30 | mA |
| | | ECP2-20 | 30 | mA |
| | | ECP2-35 | 30 | mA |
| | | ECP2-50 | 30 | mA |
| | | ECP2-70 | 30 | mA |
| I_{CCGPLL} | GPLL Power Supply Current (per GPLL) | ECP2-35, -50, -70 Only | 0.5 | mA |
| I_{CCSPLL} | SPLL Power Supply Current (per SPLL) | ECP2-35, -50, -70 Only | 0.5 | mA |
| I_{CCIO} | Bank Power Supply Current (per Bank) | All Devices | 3 | mA |
| I_{CCJ} | VCCJ Power Supply Current | All Devices | 4 | mA |

1. Until DONE signal is active.
2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
4. Frequency 0MHz.
5. $T_J = 25^\circ\text{C}$, power supplies at nominal voltage.
6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.
7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

LatticeECP2M Initialization Supply Current^{1, 2, 3, 4}**Over Recommended Operating Conditions**

| Symbol | Parameter | Device | Typ. ^{5, 6, 7} | Units |
|--------------|--------------------------------------|-------------|-------------------------|-------|
| I_{CC} | Core Power Supply Current | ECP2M20 | 41 | mA |
| | | ECP2M35 | 107 | mA |
| | | ECP2M50 | 169 | mA |
| | | ECP2M70 | 254 | mA |
| | | ECP2M100 | 378 | mA |
| I_{CCAUX} | Auxiliary Power Supply Current | ECP2M20 | 30 | mA |
| | | ECP2M35 | 30 | mA |
| | | ECP2M50 | 30 | mA |
| | | ECP2M70 | 30 | mA |
| | | ECP2M100 | 30 | mA |
| I_{CCGPLL} | GPLL Power Supply Current (per GPLL) | All Devices | 0.5 | mA |
| I_{CCSPLL} | SPLL Power Supply Current (per SPLL) | All Devices | 0.5 | mA |
| I_{CCIO} | Bank Power Supply Current (per Bank) | All Devices | 3 | mA |
| I_{CCJ} | VCCJ Power Supply Current | All Devices | 4 | mA |

1. Until DONE signal is active.
2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
4. Frequency 0MHz.
5. $T_J = 25^\circ\text{C}$, power supplies at nominal voltage.
6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.
7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

SERDES Power Supply Requirements (LatticeECP2M Family Only)¹

Over Recommended Operating Conditions

| Symbol | Description | Typ. ² | Units |
|---|--|-------------------|-------|
| Standby (Power Down) | | | |
| I _{CCTX-SB} | V _{CCTX} current (per channel) | 10 | μA |
| I _{CCR_X-SB} | V _{CCR_X} current (per channel) | 75 | μA |
| I _{CCIB-SB} | Input buffer current (per channel) | 0 | μA |
| I _{CCOB-SB} | Output buffer current (per channel) | 0 | μA |
| I _{CCP-SB} | SERDES PLL current (per quad) | 30 | μA |
| I _{CCAX33-SB} | SERDES termination current (per quad) | 10 | μA |
| Operating (Data Rate = 3.125 Gbps) | | | |
| I _{CCTX-OP} | V _{CCTX} current (per channel) | 19 | mA |
| I _{CCR_X-OP} | V _{CCR_X} current (per channel) | 34 | mA |
| I _{CCIB-OP} | Input buffer current (per channel) | 4 | mA |
| I _{CCOB-OP} | Output buffer current (per channel) | 13 | mA |
| I _{CCP-OP} | SERDES PLL current (per quad) | 26 | mA |
| I _{CCAX33-OP} | SERDES termination current (per quad) | 0.01 | mA |

1. Equalization enabled, pre-emphasis disabled.

2. T_J = 25°C, power supplies at nominal voltage.**SERDES Power (LatticeECP2M Family Only)**

Table 3-1 presents the SERDES power for one channel.

Table 3-1. SERDES Power¹

| Symbol | Description | Typ. ² | Units |
|-----------------------|---|-------------------|-------|
| P _{S-1CH-31} | SERDES power (one channel @ 3.125 Gbps) | 90 | mW |
| P _{S-1CH-25} | SERDES power (one channel @ 2.5 Gbps) | 87 | mW |
| P _{S-1CH-12} | SERDES power (one channel @ 1.25 Gbps) | 86 | mW |
| P _{S-1CH-02} | SERDES power (one channel @ 250 Mbps) | 76 | mW |

1. One quarter of the total quad power (includes contribution from common circuits, all channels in the quad operating, pre-emphasis disabled, equalization enabled).

2. Typical values measured at 25°C and 1.2V.

sysI/O Recommended Operating Conditions

| Standard | V_{CCIO} | | | V_{REF} (V) | | |
|--|------------|------|-------|---------------|------|-------|
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| LVC MOS 3.3 ² | 3.135 | 3.3 | 3.465 | — | — | — |
| LVC MOS 2.5 ² | 2.375 | 2.5 | 2.625 | — | — | — |
| LVC MOS 1.8 | 1.71 | 1.8 | 1.89 | — | — | — |
| LVC MOS 1.5 | 1.425 | 1.5 | 1.575 | — | — | — |
| LVC MOS 1.2 ² | 1.14 | 1.2 | 1.26 | — | — | — |
| LVTTL ² | 3.135 | 3.3 | 3.465 | — | — | — |
| PCI | 3.135 | 3.3 | 3.465 | — | — | — |
| SSTL18 ² Class I, II | 1.71 | 1.8 | 1.89 | 0.833 | 0.9 | 0.969 |
| SSTL2 ² Class I, II | 2.375 | 2.5 | 2.625 | 1.15 | 1.25 | 1.35 |
| SSTL3 ² Class I, II | 3.135 | 3.3 | 3.465 | 1.3 | 1.5 | 1.7 |
| HSTL ² 15 Class I | 1.425 | 1.5 | 1.575 | 0.68 | 0.75 | 0.9 |
| HSTL ² 18 Class I, II | 1.71 | 1.8 | 1.89 | 0.816 | 0.9 | 1.08 |
| LVDS ² | 2.375 | 2.5 | 2.625 | — | — | — |
| MLVDS25 ¹ | 2.375 | 2.5 | 2.625 | — | — | — |
| LVPECL33 ^{1,2} | 3.135 | 3.3 | 3.465 | — | — | — |
| BLVDS25 ^{1,2} | 2.375 | 2.5 | 2.625 | — | — | — |
| RSDS ^{1,2} | 2.375 | 2.5 | 2.625 | — | — | — |
| SSTL18D_I ² , II ² | 1.71 | 1.8 | 1.89 | — | — | — |
| SSTL25D_I ² , II ² | 2.375 | 2.5 | 2.625 | — | — | — |
| SSTL33D_I ² , II ² | 3.135 | 3.3 | 3.465 | — | — | — |
| HSTL15D_I ² | 1.425 | 1.5 | 1.575 | — | — | — |
| HSTL18D_I ² , II ² | 1.71 | 1.8 | 1.89 | — | — | — |

1. Inputs on chip. Outputs are implemented with the addition of external resistors.

2. Input on this standard does not depend on the value of V_{CCIO} .

sysI/O Single-Ended DC Electrical Characteristics

| Input/Output Standard | V_{IL} | | V_{IH} | | V_{OL} Max. (V) | V_{OH} Min. (V) | I_{OL}^1 (mA) | I_{OH}^1 (mA) |
|-----------------------|----------|-------------------|-------------------|----------|----------------------|----------------------|------------------|-----------------------|
| | Min. (V) | Max. (V) | Min. (V) | Max. (V) | | | | |
| LVCMOS 3.3 | -0.3 | 0.8 | 2.0 | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 20, 16, 12, 8, 4 | -20, -16, -12, -8, -4 |
| | | | | | 0.2 | $V_{CCIO} - 0.2$ | 0.1 | -0.1 |
| LVTTTL | -0.3 | 0.8 | 2.0 | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 20, 16, 12, 8, 4 | -20, -16, -12, -8, -4 |
| | | | | | 0.2 | $V_{CCIO} - 0.2$ | 0.1 | -0.1 |
| LVCMOS 2.5 | -0.3 | 0.7 | 1.7 | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 20, 16, 12, 8, 4 | -20, -16, -12, -8, -4 |
| | | | | | 0.2 | $V_{CCIO} - 0.2$ | 0.1 | -0.1 |
| LVCMOS 1.8 | -0.3 | $0.35 V_{CCIO}$ | $0.65 V_{CCIO}$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 16, 12, 8, 4 | -16, -12, -8, -4 |
| | | | | | 0.2 | $V_{CCIO} - 0.2$ | 0.1 | -0.1 |
| LVCMOS 1.5 | -0.3 | $0.35 V_{CCIO}$ | $0.65 V_{CCIO}$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 8, 4 | -8, -4 |
| | | | | | 0.2 | $V_{CCIO} - 0.2$ | 0.1 | -0.1 |
| LVCMOS 1.2 | -0.3 | $0.35 V_{CC}$ | $0.65 V_{CC}$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 6, 2 | -6, -2 |
| | | | | | 0.2 | $V_{CCIO} - 0.2$ | 0.1 | -0.1 |
| PCI | -0.3 | $0.3 V_{CCIO}$ | $0.5 V_{CCIO}$ | 3.6 | $0.1 V_{CCIO}$ | $0.9 V_{CCIO}$ | 1.5 | -0.5 |
| SSTL3 Class I | -0.3 | $V_{REF} - 0.2$ | $V_{REF} + 0.2$ | 3.6 | 0.7 | $V_{CCIO} - 1.1$ | 8 | -8 |
| SSTL3 Class II | -0.3 | $V_{REF} - 0.2$ | $V_{REF} + 0.2$ | 3.6 | 0.5 | $V_{CCIO} - 0.9$ | 16 | -16 |
| SSTL2 Class I | -0.3 | $V_{REF} - 0.18$ | $V_{REF} + 0.18$ | 3.6 | 0.54 | $V_{CCIO} - 0.62$ | 7.6 | -7.6 |
| | | | | | | | 12 | -12 |
| SSTL2 Class II | -0.3 | $V_{REF} - 0.18$ | $V_{REF} + 0.18$ | 3.6 | 0.35 | $V_{CCIO} - 0.43$ | 15.2 | -15.2 |
| | | | | | | | 20 | -20 |
| SSTL18 Class I | -0.3 | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 6.7 | -6.7 |
| SSTL18 Class II | -0.3 | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | 3.6 | 0.28 | $V_{CCIO} - 0.28$ | 8 | -8 |
| | | | | | | | 11 | -11 |
| HSTL Class I | -0.3 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 4 | -4 |
| | | | | | | | 8 | -8 |
| HSTL18 Class I | -0.3 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 8 | -8 |
| | | | | | | | 12 | -12 |
| HSTL18 Class II | -0.3 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 3.6 | 0.4 | $V_{CCIO} - 0.4$ | 16 | -16 |

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8mA$, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

sys/I/O Differential Electrical Characteristics**LVDS****Over Recommended Operating Conditions**

| Parameter | Description | Test Conditions | Min. | Typ. | Max. | Units |
|---------------------|--|--|--------|------|-------|---------|
| V_{INP} V_{INM} | Input Voltage | | 0 | — | 2.4 | V |
| V_{CM} | Input Common Mode Voltage | Half the Sum of the Two Inputs | 0.05 | — | 2.35 | V |
| V_{THD} | Differential Input Threshold | Difference Between the Two Inputs | +/-100 | — | — | mV |
| I_{IN} | Input Current | Power On or Power Off | — | — | +/-10 | μ A |
| V_{OH} | Output High Voltage for V_{OP} or V_{OM} | $R_T = 100$ Ohm | — | 1.38 | 1.60 | V |
| V_{OL} | Output Low Voltage for V_{OP} or V_{OM} | $R_T = 100$ Ohm | 0.9V | 1.03 | — | V |
| V_{OD} | Output Voltage Differential | $(V_{OP} - V_{OM})$, $R_T = 100$ Ohm | 250 | 350 | 450 | mV |
| ΔV_{OD} | Change in V_{OD} Between High and Low | | — | — | 50 | mV |
| V_{OS} | Output Voltage Offset | $(V_{OP} + V_{OM})/2$, $R_T = 100$ Ohm | 1.125 | 1.20 | 1.375 | V |
| ΔV_{OS} | Change in V_{OS} Between H and L | | — | — | 50 | mV |
| I_{SA} | Output Short Circuit Current | $V_{OD} = 0V$ Driver Outputs Shorted to Ground | — | — | 24 | mA |
| I_{SAB} | Output Short Circuit Current | $V_{OD} = 0V$ Driver Outputs Shorted to Each Other | — | — | 12 | mA |

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

LVDS25E

The top and bottom sides of LatticeECP2/M devices support LVDS outputs via emulated complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in Figure 3-1 is one possible solution for point-to-point signals.

Figure 3-1. LVDS25E Output Termination Example

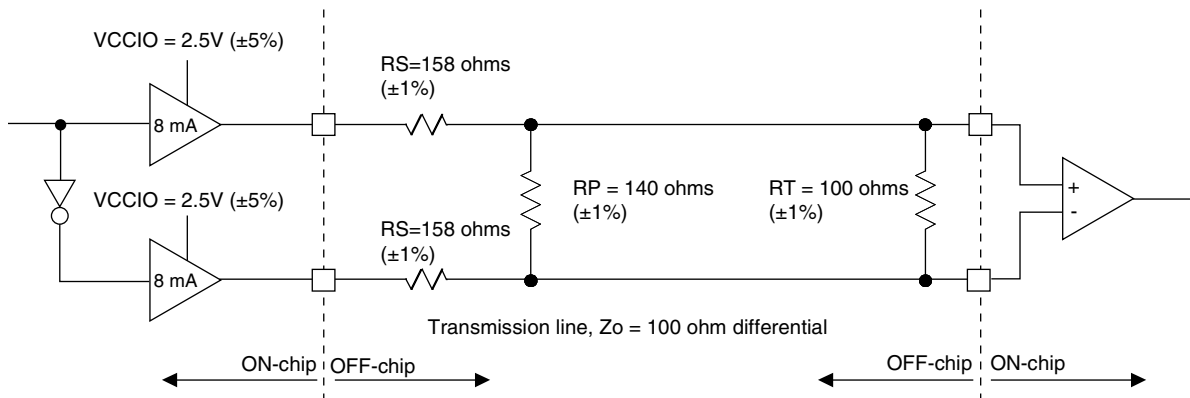


Table 3-2. LVDS25E DC Conditions

| Parameter | Description | Typical | Units |
|-------------------|----------------------------------|---------|-------|
| V _{CCIO} | Output Driver Supply (+/-5%) | 2.50 | V |
| Z _{OUT} | Driver Impedance | 20 | Ω |
| R _S | Driver Series Resistor (+/-1%) | 158 | Ω |
| R _P | Driver Parallel Resistor (+/-1%) | 140 | Ω |
| R _T | Receiver Termination (+/-1%) | 100 | Ω |
| V _{OH} | Output High Voltage | 1.43 | V |
| V _{OL} | Output Low Voltage | 1.07 | V |
| V _{OD} | Output Differential Voltage | 0.35 | V |
| V _{CM} | Output Common Mode Voltage | 1.25 | V |
| Z _{BACK} | Back Impedance | 100.5 | Ω |
| I _{DC} | DC Output Current | 6.03 | mA |

LVCMOS33D

All I/O banks support emulated differential I/O using the LVCMOS33D I/O type. This option, along with the external resistor network, provides the system designer the flexibility to place differential outputs on an I/O bank with 3.3V VCCIO. The default drive current for LVCMOS33D output is 12mA with the option to change the device strength to 4mA, 8mA, 16mA or 20mA. Follow the LVCMOS33 specifications for the DC characteristics of the LVCMOS33D.

BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVC-MOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

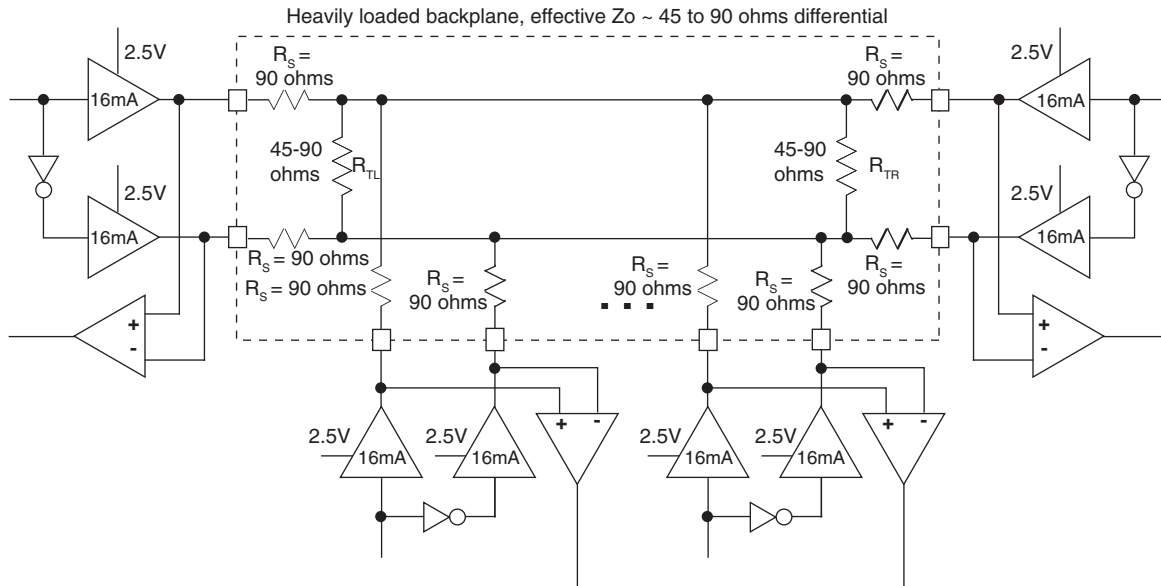


Table 3-3. BLVDS DC Conditions¹

Over Recommended Operating Conditions

| Parameter | Description | Typical | | Units |
|-----------|-----------------------------------|----------|----------|-------|
| | | Zo = 45Ω | Zo = 90Ω | |
| VCCIO | Output Driver Supply (+/- 5%) | 2.50 | 2.50 | V |
| ZOUT | Driver Impedance | 10.00 | 10.00 | Ω |
| RS | Driver Series Resistor (+/- 1%) | 90.00 | 90.00 | Ω |
| RTL | Driver Parallel Resistor (+/- 1%) | 45.00 | 90.00 | Ω |
| TR | Receiver Termination (+/- 1%) | 45.00 | 90.00 | Ω |
| VOH | Output High Voltage | 1.38 | 1.48 | V |
| VOL | Output Low Voltage | 1.12 | 1.02 | V |
| VOD | Output Differential Voltage | 0.25 | 0.46 | V |
| VCM | Output Common Mode Voltage | 1.25 | 1.25 | V |
| IDC | DC Output Current | 11.24 | 10.20 | mA |

1. For input buffer, see LVDS table.

LVPECL

The LatticeECP2/M devices support the differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

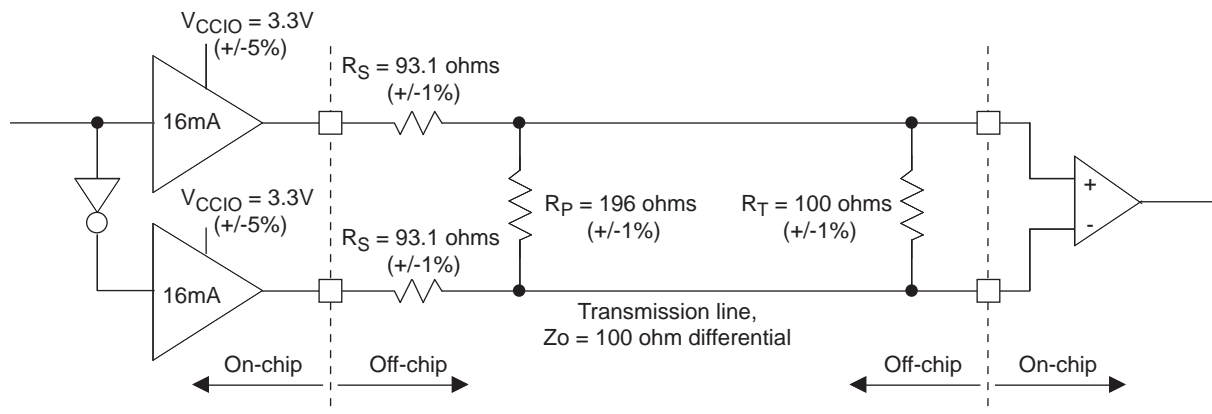


Table 3-4. LVPECL DC Conditions¹

Over Recommended Operating Conditions

| Parameter | Description | Typical | Units |
|------------|----------------------------------|---------|----------|
| V_{CCIO} | Output Driver Supply (+/-5%) | 3.30 | V |
| Z_{OUT} | Driver Impedance | 10 | Ω |
| R_S | Driver Series Resistor (+/-1%) | 93 | Ω |
| R_P | Driver Parallel Resistor (+/-1%) | 196 | Ω |
| R_T | Receiver Termination (+/-1%) | 100 | Ω |
| V_{OH} | Output High Voltage | 2.05 | V |
| V_{OL} | Output Low Voltage | 1.25 | V |
| V_{OD} | Output Differential Voltage | 0.80 | V |
| V_{CM} | Output Common Mode Voltage | 1.65 | V |
| Z_{BACK} | Back Impedance | 100.5 | Ω |
| I_{DC} | DC Output Current | 12.11 | mA |

1. For input buffer, see LVDS table.

RSDS

The LatticeECP2/M devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Signaling)

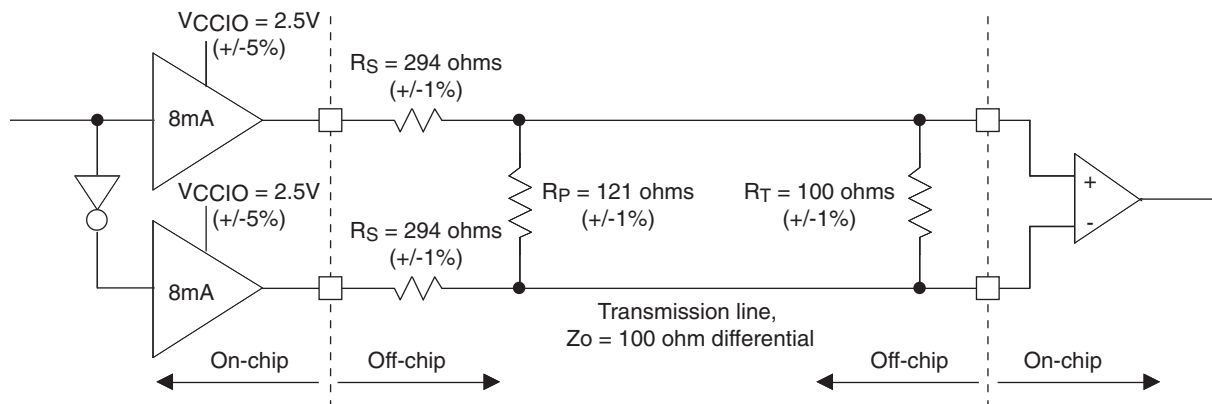


Table 3-5. RSDS DC Conditions¹

Over Recommended Operating Conditions

| Parameter | Description | Typical | Units |
|-------------------|----------------------------------|---------|-------|
| V _{CCIO} | Output Driver Supply (+/-5%) | 2.50 | V |
| Z _{OUT} | Driver Impedance | 20 | Ω |
| R _S | Driver Series Resistor (+/-1%) | 294 | Ω |
| R _P | Driver Parallel Resistor (+/-1%) | 121 | Ω |
| R _T | Receiver Termination (+/-1%) | 100 | Ω |
| V _{OH} | Output High Voltage | 1.35 | V |
| V _{OL} | Output Low Voltage | 1.15 | V |
| V _{OD} | Output Differential Voltage | 0.20 | V |
| V _{CM} | Output Common Mode Voltage | 1.25 | V |
| Z _{BACK} | Back Impedance | 101.5 | Ω |
| I _{DC} | DC Output Current | 3.66 | mA |

1. For input buffer, see LVDS table.

MLVDS

The LatticeECP2/M devices support the differential MLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The MLVDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-5 is one possible solution for MLVDS standard implementation. Resistor values in Figure 3-5 are industry standard values for 1% resistors.

Figure 3-5. MLVDS (Multipoint Low Voltage Differential Signaling)

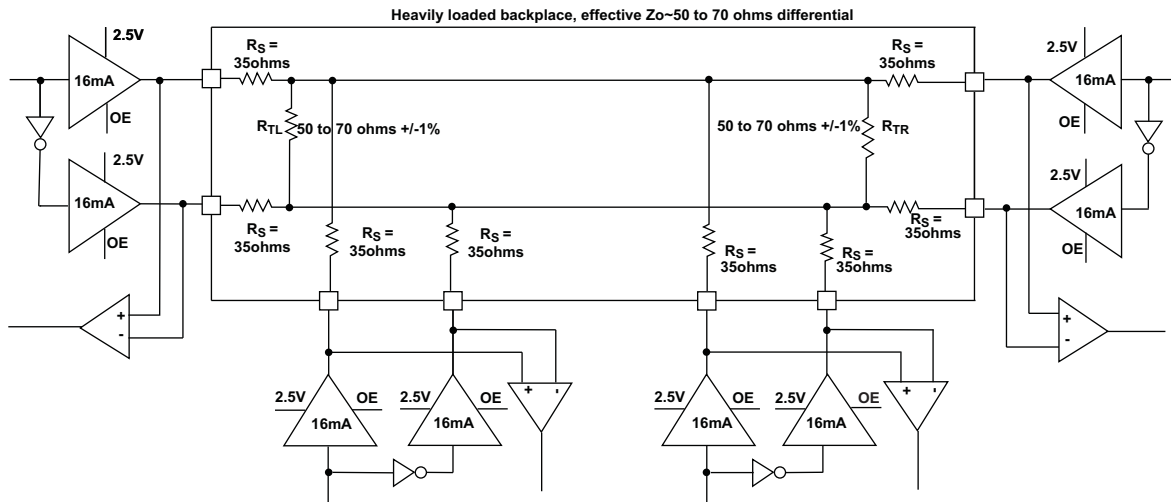


Table 3-6. MLVDS DC Conditions¹

| Parameter | Description | Typical | | Units |
|------------|----------------------------------|----------------|----------------|----------|
| | | $Z_o=50\Omega$ | $Z_o=70\Omega$ | |
| V_{CCIO} | Output Driver Supply (+/-5%) | 2.50 | 2.50 | V |
| Z_{OUT} | Driver Impedance | 10.00 | 10.00 | Ω |
| R_S | Driver Series Resistor (+/-1%) | 35.00 | 35.00 | Ω |
| R_{TL} | Driver Parallel Resistor (+/-1%) | 50.00 | 70.00 | Ω |
| R_{TR} | Receiver Termination (+/-1%) | 50.00 | 70.00 | Ω |
| V_{OH} | Output High Voltage | 1.52 | 1.60 | V |
| V_{OL} | Output Low Voltage | 0.98 | 0.90 | V |
| V_{OD} | Output Differential Voltage | 0.54 | 0.70 | V |
| V_{CM} | Output Common Mode Voltage | 1.25 | 1.25 | V |
| I_{DC} | DC Output Current | 21.74 | 20.00 | mA |

1. For input buffer, see LVDS table.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

Typical Building Block Function Performance¹**Pin-to-Pin Performance (LVCMOS25 12mA Drive)**

| Function | -7 Timing | Units |
|------------------------|-----------|-------|
| Basic Functions | | |
| 16-bit Decoder | 3.8 | ns |
| 32-bit Decoder | 4.5 | ns |
| 64-bit Decoder | 5.0 | ns |
| 4:1 MUX | 3.2 | ns |
| 8:1 MUX | 3.4 | ns |
| 16:1 MUX | 3.5 | ns |
| 32:1 MUX | 4.0 | ns |

1. These timing numbers were generated using the ispLEVER 8.0 design tool. Exact performance may vary with device and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

Register-to-Register Performance

| Function | -7 Timing | Units |
|--|-----------|-------|
| Basic Functions | | |
| 16-bit Decoder | 599 | MHz |
| 32-bit Decoder | 542 | MHz |
| 64-bit Decoder | 417 | MHz |
| 4:1 MUX | 847 | MHz |
| 8:1 MUX | 803 | MHz |
| 16:1 MUX | 660 | MHz |
| 32:1 MUX | 577 | MHz |
| 8-bit Adder | 591 | MHz |
| 16-bit Adder | 500 | MHz |
| 64-bit Adder | 306 | MHz |
| 16-bit Counter | 488 | MHz |
| 32-bit Counter | 378 | MHz |
| 64-bit Counter | 260 | MHz |
| 64-bit Accumulator | 253 | MHz |
| Embedded Memory Functions | | |
| 512x36 Single Port RAM, EBR Output Registers | 370 | MHz |
| 1024x18 True-Dual Port RAM (Write Through or Normal, EBR Output Registers) | 370 | MHz |
| 1024x18 True-Dual Port RAM (Write Through or Normal, PLC Output Registers) | 280 | MHz |
| Distributed Memory Functions | | |
| 16x4 Pseudo-Dual Port RAM (One PFU) | 819 | MHz |
| 32x4 Pseudo-Dual Port RAM | 521 | MHz |
| 64x8 Pseudo-Dual Port RAM | 435 | MHz |
| DSP Functions | | |
| 18x18 Multiplier (All Registers) | 420 | MHz |
| 9x9 Multiplier (All Registers) | 420 | MHz |

Register-to-Register Performance (Continued)

| Function | -7 Timing | Units |
|--|-----------|-------|
| 36x36 Multiplier (All Registers) | 372 | MHz |
| 18x18 Multiplier/Accumulate (Input and Output Registers) | 295 | MHz |
| 18x18 Multiplier-Add/Sub-Sum (All Registers) | 420 | MHz |
| DSP IP Functions | | |
| 16-Tap Fully-Parallel FIR Filter | 304 | MHz |
| 1024-pt, Radix 4, Decimation in Frequency FFT | 227 | MHz |
| 8x8 Matrix Multiplier | 223 | MHz |

Derating Timing Tables

Logic timing provided in the following sections of this data sheet and the Diamond design tool are worst case numbers in the operating range. Actual delays at nominal temperature and voltage for best case process, can be much better than the values given in the tables. The Diamond design tool can provide logic timing numbers at a particular temperature and voltage.

LatticeECP2/M External Switching Characteristics⁹

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|---|--|----------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| General I/O Pin Parameters (using Primary Clock without PLL)¹ | | | | | | | | | |
| t _{CO} | Clock to Output - PIO Output Register | LFE2-6 | — | 3.50 | — | 3.90 | — | 4.20 | ns |
| | | LFE2-12 | — | 3.50 | — | 3.90 | — | 4.20 | ns |
| | | LFE2-20 | — | 3.50 | — | 3.90 | — | 4.20 | ns |
| | | LFE2-35 | — | 3.50 | — | 3.90 | — | 4.20 | ns |
| | | LFE2-50 | — | 3.50 | — | 3.90 | — | 4.20 | ns |
| | | LFE2-70 | — | 3.70 | — | 4.10 | — | 4.40 | ns |
| | | LFE2M20 | — | 3.90 | — | 4.30 | — | 4.70 | ns |
| | | LFE2M35 | — | 3.90 | — | 4.30 | — | 4.70 | ns |
| | | LFE2M50 | — | 4.50 | — | 5.00 | — | 5.40 | ns |
| | | LFE2M70 | — | 4.50 | — | 5.00 | — | 5.40 | ns |
| | | LFE2M100 | — | 4.50 | — | 5.00 | — | 5.40 | ns |
| t _{SU} | Clock to Data Setup - PIO Input Register | LFE2-6 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-12 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M100 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| t _H | Clock to Data Hold - PIO Input Register | LFE2-6 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-12 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-20 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-35 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-50 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-70 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M20 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M35 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M50 | 1.80 | — | 2.10 | — | 2.30 | — | ns |
| | | LFE2M70 | 1.80 | — | 2.10 | — | 2.30 | — | ns |
| | | LFE2M100 | 1.80 | — | 2.10 | — | 2.30 | — | ns |

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|--|--|---------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{SU_DEL} | Clock to Data Setup - PIO Input Register with Data Input Delay | LFE2-6 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-12 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-20 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-35 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-50 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2-70 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M20 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M35 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M50 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| | | LFE2M70 | 1.40 | — | 1.70 | — | 1.90 | — | ns |
| LFE2M100 | 1.40 | — | 1.70 | — | 1.90 | — | ns | | |
| t _{H_DEL} | Clock to Data Hold - PIO Input Register with Input Data Delay | LFE2-6 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-12 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| LFE2M100 | 0.00 | — | 0.00 | — | 0.00 | — | ns | | |
| f _{MAX_IO} | Clock Frequency of I/O Register and PFU Register | ECP2/M | — | 420 | — | 357 | — | 311 | MHz |
| General I/O Pin Parameters (using Edge Clock without PLL)¹ | | | | | | | | | |
| t _{COE} | Clock to Output - PIO Output Register | LFE2-6 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2-12 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2-20 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2-35 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2-50 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2-70 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2M20 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2M35 | — | 2.60 | — | 2.90 | — | 3.20 | ns |
| | | LFE2M50 | — | 3.10 | — | 3.40 | — | 3.70 | ns |
| | | LFE2M70 | — | 3.10 | — | 3.40 | — | 3.70 | ns |
| LFE2M100 | — | 3.10 | — | 3.40 | — | 3.70 | ns | | |

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|----------------------|--|----------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{SUE} | Clock to Data Setup - PIO Input Register | LFE2-6 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-12 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M100 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| t _{HE} | Clock to Data Hold - PIO Input Register | LFE2-6 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2-12 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2-20 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2-35 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2-50 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2-70 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2M20 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2M35 | 0.90 | — | 1.10 | — | 1.30 | — | ns |
| | | LFE2M50 | 1.20 | — | 1.40 | — | 1.60 | — | ns |
| | | LFE2M70 | 1.20 | — | 1.40 | — | 1.60 | — | ns |
| | | LFE2M100 | 1.20 | — | 1.40 | — | 1.60 | — | ns |
| t _{SU_DELE} | Clock to Data Setup - PIO Input Register with Data Input Delay | LFE2-6 | 1.00 | — | 1.30 | — | 1.60 | — | ns |
| | | LFE2-12 | 1.00 | — | 1.30 | — | 1.60 | — | ns |
| | | LFE2-20 | 1.00 | — | 1.30 | — | 1.60 | — | ns |
| | | LFE2-35 | 1.00 | — | 1.30 | — | 1.60 | — | ns |
| | | LFE2-50 | 1.00 | — | 1.30 | — | 1.60 | — | ns |
| | | LFE2-70 | 1.00 | — | 1.30 | — | 1.60 | — | ns |
| | | LFE2M20 | 1.20 | — | 1.60 | — | 1.90 | — | ns |
| | | LFE2M35 | 1.20 | — | 1.60 | — | 1.90 | — | ns |
| | | LFE2M50 | 1.20 | — | 1.60 | — | 1.90 | — | ns |
| | | LFE2M70 | 1.20 | — | 1.60 | — | 1.90 | — | ns |
| | | LFE2M100 | 1.20 | — | 1.60 | — | 1.90 | — | ns |

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|--|---|----------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{H_DELE} | Clock to Data Hold - PIO Input Register with Input Data Delay | LFE2-6 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-12 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M100 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| f _{MAX_IOE} | Clock Frequency of I/O and PFU Register | ECP2/M | — | 420 | — | 357 | — | 311 | MHz |
| General I/O Pin Parameters (using Primary Clock with PLL)¹ | | | | | | | | | |
| t _{COPLL} ¹⁰ | Clock to Output - PIO Output Register | LFE2-6 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2-12 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2-20 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2-35 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2-50 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2-70 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2M20 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2M35 | — | 2.30 | — | 2.60 | — | 2.80 | ns |
| | | LFE2M50 | — | 2.60 | — | 2.90 | — | 3.10 | ns |
| | | LFE2M70 | — | 2.60 | — | 2.90 | — | 3.10 | ns |
| | | LFE2M100 | — | 2.70 | — | 3.00 | — | 3.20 | ns |
| t _{SUPLL} | Clock to Data Setup - PIO Input Register | LFE2-6 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2-12 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2-20 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2-35 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2-50 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2-70 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2M20 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2M35 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2M50 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2M70 | 0.70 | — | 0.80 | — | 0.90 | — | ns |
| | | LFE2M100 | 0.80 | — | 0.90 | — | 1.00 | — | ns |

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|--|--|---------|-------|-------|-------|-------|-------|-------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{HPLL} | Clock to Data Hold - PIO Input Register | LFE2-6 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2-12 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2-20 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2-35 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2-50 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2-70 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2M20 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2M35 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2M50 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| | | LFE2M70 | 1.00 | — | 1.20 | — | 1.40 | — | ns |
| LFE2M100 | 1.00 | — | 1.20 | — | 1.40 | — | ns | | |
| t _{SU_DELPLL} | Clock to Data Setup - PIO Input Register with Data Input Delay | LFE2-6 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2-12 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2-20 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2-35 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2-50 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2-70 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2M20 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2M35 | 1.80 | — | 2.00 | — | 2.20 | — | ns |
| | | LFE2M50 | 1.90 | — | 2.10 | — | 2.30 | — | ns |
| | | LFE2M70 | 1.90 | — | 2.10 | — | 2.30 | — | ns |
| LFE2M100 | 2.00 | — | 2.20 | — | 2.40 | — | ns | | |
| t _{H_DELPLL} | Clock to Data Hold - PIO Input Register with Input Data Delay | LFE2-6 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-12 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2-70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M20 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M35 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M50 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| | | LFE2M70 | 0.00 | — | 0.00 | — | 0.00 | — | ns |
| LFE2M100 | 0.00 | — | 0.00 | — | 0.00 | — | ns | | |
| DDR I/O Pin Parameters² | | | | | | | | | |
| t _{DVADQ} | Data Valid After DQS (DDR Read) | ECP2/M | — | 0.225 | — | 0.225 | — | 0.225 | UI |
| t _{DVEDQ} | Data Hold After DQS (DDR Read) | ECP2/M | 0.640 | — | 0.640 | — | 0.640 | — | UI |
| t _{DQVBS} | Data Valid Before DQS (DDR Write) | ECP2/M | 0.250 | — | 0.250 | — | 0.250 | — | UI |
| t _{DQVAS} | Data Valid After DQS (DDR Write) | ECP2/M | 0.250 | — | 0.250 | — | 0.250 | — | UI |
| f _{MAX_DDR} | DDR Clock Frequency ⁶ | ECP2/M | 95 | 200 | 95 | 166 | 95 | 133 | MHz |
| DDR2 I/O Pin Parameters³ | | | | | | | | | |
| t _{DVADQ} | Data Valid After DQS (DDR Read) | ECP2/M | — | 0.225 | — | 0.225 | — | 0.225 | UI |
| t _{DVEDQ} | Data Hold After DQS (DDR Read) | ECP2/M | 0.640 | — | 0.640 | — | 0.640 | — | UI |

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|--|-------------------------------------|----------|-------|------|-------|------|-------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{DQVBS} | Data Valid Before DQS (DDR Write) | ECP2/M | 0.250 | — | 0.250 | — | 0.250 | — | UI |
| t _{DQVAS} | Data Valid After DQS (DDR Write) | ECP2/M | 0.250 | — | 0.250 | — | 0.250 | — | UI |
| f _{MAX_DDR2} | DDR Clock Frequency | ECP2/M | 133 | 266 | 133 | 200 | 133 | 166 | MHz |
| SPI4.2 I/O Pin Parameters Static Alignment^{4, 8, 11} | | | | | | | | | |
| | Maximum Data Rate | ECP2-20 | — | 750 | — | 622 | — | 622 | Mbps |
| | | ECP2-35 | — | 750 | — | 622 | — | 622 | Mbps |
| | | ECP2-50 | — | 750 | — | 622 | — | 622 | Mbps |
| | | ECP2-70 | — | 750 | — | 622 | — | 622 | Mbps |
| | | ECP2M20 | — | 622 | — | 622 | — | 622 | Mbps |
| | | ECP2M35 | — | 622 | — | 622 | — | 622 | Mbps |
| | | ECP2M50 | — | 622 | — | 622 | — | 622 | Mbps |
| | | ECP2M70 | — | 622 | — | 622 | — | 622 | Mbps |
| | | ECP2M100 | — | 622 | — | 622 | — | 622 | Mbps |
| t _{DVACLKSPI} | Data Valid After CLK (Receive) | ECP2-20 | — | 0.25 | — | 0.25 | — | 0.25 | UI |
| | | ECP2-35 | — | 0.25 | — | 0.25 | — | 0.25 | UI |
| | | ECP2-50 | — | 0.25 | — | 0.25 | — | 0.25 | UI |
| | | ECP2-70 | — | 0.25 | — | 0.25 | — | 0.25 | UI |
| | | ECP2M20 | — | 0.21 | — | 0.21 | — | 0.21 | UI |
| | | ECP2M35 | — | 0.21 | — | 0.21 | — | 0.21 | UI |
| | | ECP2M50 | — | 0.21 | — | 0.21 | — | 0.21 | UI |
| | | ECP2M70 | — | 0.21 | — | 0.21 | — | 0.21 | UI |
| | | ECP2M100 | — | 0.21 | — | 0.21 | — | 0.21 | UI |
| t _{DVECLKSPI} | Data Hold After CLK (Receive) | ECP2-20 | 0.75 | — | 0.75 | — | 0.75 | — | UI |
| | | ECP2-35 | 0.75 | — | 0.75 | — | 0.75 | — | UI |
| | | ECP2-50 | 0.75 | — | 0.75 | — | 0.75 | — | UI |
| | | ECP2-70 | 0.75 | — | 0.75 | — | 0.75 | — | UI |
| | | ECP2M20 | 0.79 | — | 0.79 | — | 0.79 | — | UI |
| | | ECP2M35 | 0.79 | — | 0.79 | — | 0.79 | — | UI |
| | | ECP2M50 | 0.79 | — | 0.79 | — | 0.79 | — | UI |
| | | ECP2M70 | 0.79 | — | 0.79 | — | 0.79 | — | UI |
| | | ECP2M100 | 0.79 | — | 0.79 | — | 0.79 | — | UI |
| t _{DIASPI} | Data Invalid After Clock (Transmit) | ECP2-20 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2-35 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2-50 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2-70 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2M20 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M35 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M50 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M70 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M100 | — | 230 | — | 230 | — | 230 | ps |

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Device | -7 | | -6 | | -5 | | Units |
|--|--|---------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{DIBSPI} | Data Invalid Before Clock (Transmit) | ECP2-20 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2-35 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2-50 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2-70 | — | 280 | — | 280 | — | 280 | ps |
| | | ECP2M20 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M35 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M50 | — | 230 | — | 230 | — | 230 | ps |
| | | ECP2M70 | — | 230 | — | 230 | — | 230 | ps |
| ECP2M100 | — | 230 | — | 230 | — | 230 | ps | | |
| XGMII I/O Pin Parameters (312 Mbps)⁵ | | | | | | | | | |
| t _{SUXGMII} | Data Setup Before Read Clock | ECP2/M | 480 | — | 480 | — | 480 | — | ps |
| t _{HXGMII} | Data Hold After Read Clock | ECP2/M | 480 | — | 480 | — | 480 | — | ps |
| t _{DVBCKXGMII} | Data Valid Before Clock | ECP2/M | 960 | — | 960 | — | 960 | — | ps |
| t _{DVACKXGMII} | Data Valid After Clock | ECP2/M | 960 | — | 960 | — | 960 | — | ps |
| Primary | | | | | | | | | |
| f _{MAX_PRI} ⁷ | Frequency for Primary Clock Tree | ECP2/M | — | 420 | — | 357 | — | 311 | MHz |
| t _{W_PRI} | Clock Pulse Width for Primary Clock | ECP2/M | 0.95 | — | 1.19 | — | 2.00 | — | ns |
| t _{SKEW_PRI} | Primary Clock Skew Within a Bank | ECP2/M | — | 300 | — | 360 | — | 420 | ps |
| Edge Clock | | | | | | | | | |
| f _{MAX_EDGE} ⁷ | Frequency for Edge Clock | ECP2/M | — | 420 | — | 357 | — | 311 | MHz |
| t _{W_EDGE} | Clock Pulse Width for Edge Clock | ECP2/M | 0.95 | — | 1.19 | — | 2.00 | — | ns |
| t _{SKEW_EDGE} | Edge Clock Skew Within an Edge of the Device | ECP2/M | — | 300 | — | 360 | — | 420 | ps |

1. General timing numbers based on LVCMOS 2.5, 12mA, 0pf load.
2. DDR timing numbers based on SSTL25 for BGA packages only.
3. DDR2 timing numbers based on SSTL18 for BGA packages only.
4. SPI4.2 and SF14 timing numbers based on LVDS25 for BGA packages only.
5. XGMII timing numbers based on HSTL class I. A corresponding left/right dedicated clock buffer is used when using the SPI4.2 interface to the left or right edge of the device. For SPI4.2 mode, the software tool will help in selecting the appropriate clock buffer.
6. IP will be used to support DDR and DDR2 memory data rates down to 95MHz. This approach uses a free-running clock and PFU register to sample the data instead of the hardwired DDR memory interface.
7. Using the LVDS I/O standard.
8. ECP2-6 and ECP2-12 do not support SPI4.2
9. The AC numbers do not apply to PCLK6 and PCLK7.
10. Applies to CLKOP only.
11. Please refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#) for best performance.

Figure 3-6. SPI4.2 Parameters

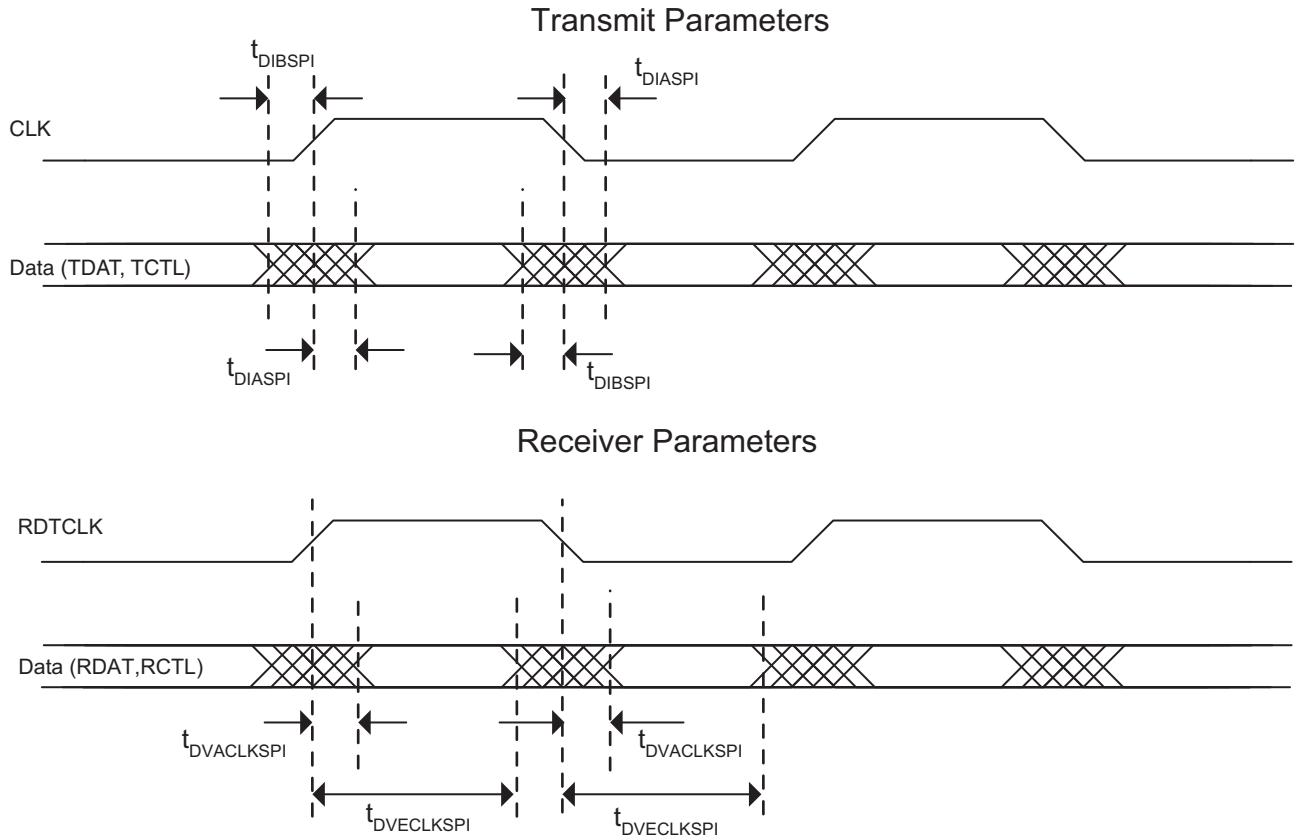


Figure 3-7. DDR and DDR2 Parameters

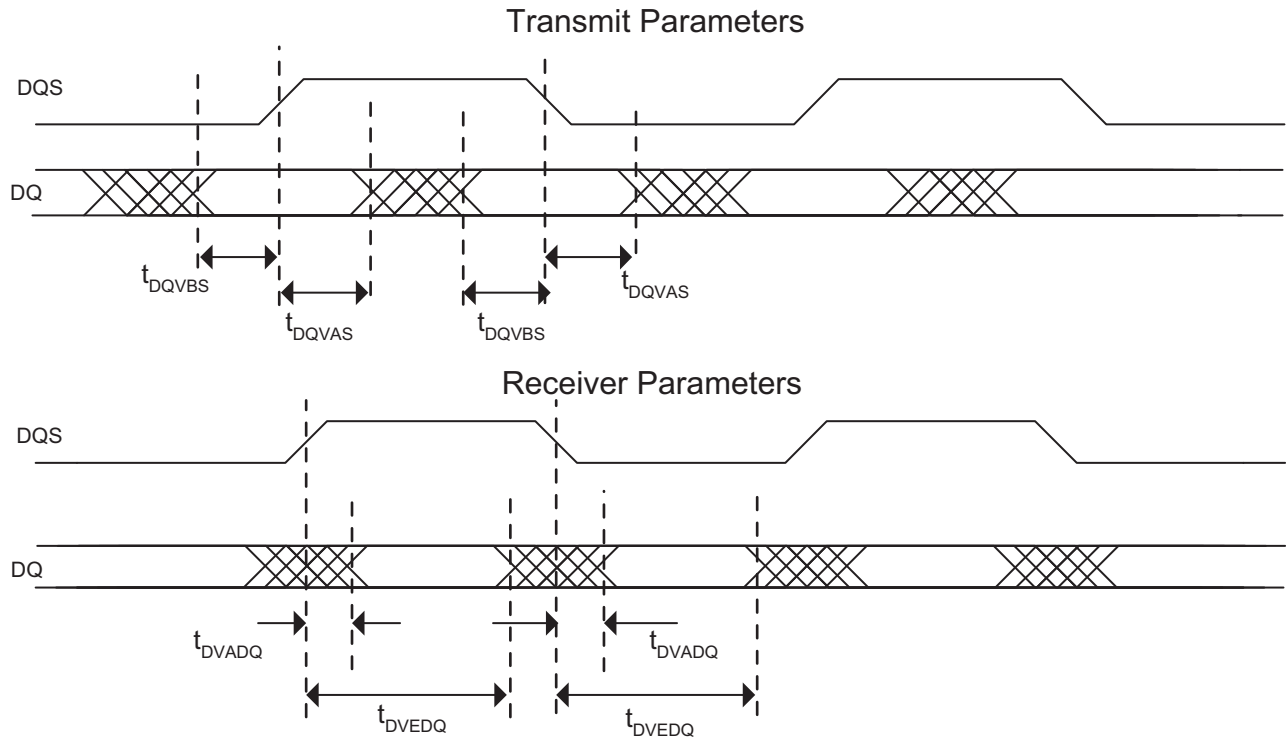
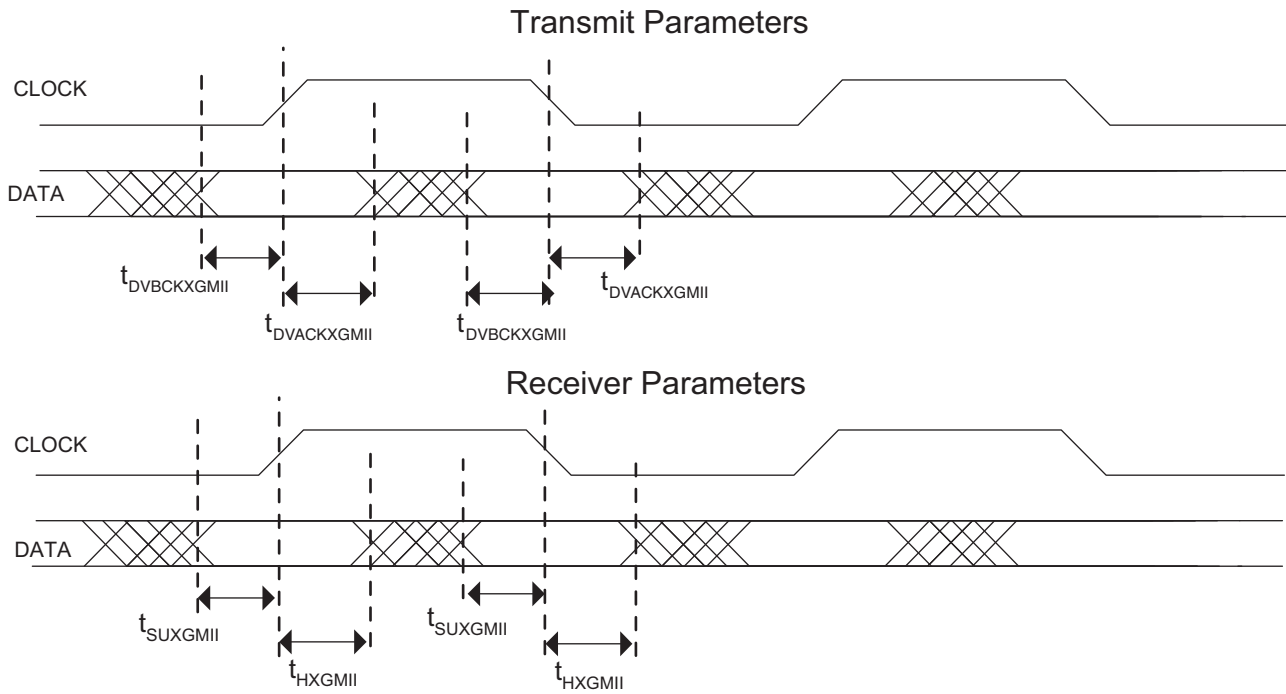


Figure 3-8. XGMII Parameters



LatticeECP2/M Internal Switching Characteristics¹

Over Recommended Operating Conditions

| Parameter | Description | -7 | | -6 | | -5 | | Units |
|---|---|--------|-------|--------|-------|--------|-------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| PFU/PFF Logic Mode Timing | | | | | | | | |
| t _{LUT4_PFU} | LUT4 delay (A to D inputs to F output) | — | 0.180 | — | 0.198 | — | 0.216 | ns |
| t _{LUT6_PFU} | LUT6 delay (A to D inputs to OFX output) | — | 0.304 | — | 0.331 | — | 0.358 | ns |
| t _{LSR_PFU} | Set/Reset to output of PFU (Asynchronous) | — | 0.600 | — | 0.655 | — | 0.711 | ns |
| t _{SUM_PFU} | Clock to Mux (M0,M1) Input Setup Time | 0.128 | — | 0.129 | — | 0.129 | — | ns |
| t _{HM_PFU} | Clock to Mux (M0,M1) Input Hold Time | -0.051 | — | -0.049 | — | -0.046 | — | ns |
| t _{SUD_PFU} | Clock to D input setup time | 0.061 | — | 0.071 | — | 0.081 | — | ns |
| t _{HD_PFU} | Clock to D input hold time | 0.002 | — | 0.003 | — | 0.003 | — | ns |
| t _{CK2Q_PFU} | Clock to Q delay, (D-type Register Configuration) | — | 0.285 | — | 0.309 | — | 0.333 | ns |
| PFU Dual Port Memory Mode Timing | | | | | | | | |
| t _{CORAM_PFU} | Clock to Output (F Port) | — | 0.902 | — | 1.083 | — | 1.263 | ns |
| t _{SUDATA_PFU} | Data Setup Time | -0.172 | — | -0.205 | — | -0.238 | — | ns |
| t _{HDATA_PFU} | Data Hold Time | 0.199 | — | 0.235 | — | 0.271 | — | ns |
| t _{SUADDR_PFU} | Address Setup Time | -0.245 | — | -0.284 | — | -0.323 | — | ns |
| t _{HADDR_PFU} | Address Hold Time | 0.246 | — | 0.285 | — | 0.324 | — | ns |
| t _{SUWREN_PFU} | Write/Read Enable Setup Time | -0.122 | — | -0.145 | — | -0.168 | — | ns |
| t _{HWREN_PFU} | Write/Read Enable Hold Time | 0.132 | — | 0.156 | — | 0.180 | — | ns |
| PIC Timing | | | | | | | | |
| PIO Input/Output Buffer Timing | | | | | | | | |
| t _{IN_PIO} | Input Buffer Delay (LVCMOS25) | — | 0.613 | — | 0.681 | — | 0.749 | ns |
| t _{OUT_PIO} | Output Buffer Delay (LVCMOS25) | — | 1.115 | — | 1.115 | — | 1.343 | ns |
| IOLOGIC Input/Output Timing | | | | | | | | |
| t _{SUI_PIO} | Input Register Setup Time (Data Before Clock) | 0.596 | — | 0.645 | — | 0.694 | — | ns |
| t _{HI_PIO} | Input Register Hold Time (Data after Clock) | -0.570 | — | -0.614 | — | -0.658 | — | ns |
| t _{COO_PIO} | Output Register Clock to Output Delay | — | 0.61 | — | 0.66 | — | 0.72 | ns |
| t _{SUCE_PIO} | Input Register Clock Enable Setup Time | 0.032 | — | 0.037 | — | 0.041 | — | ns |
| t _{HCE_PIO} | Input Register Clock Enable Hold Time | -0.022 | — | -0.025 | — | -0.028 | — | ns |
| t _{SULSR_PIO} | Set/Reset Setup Time | 0.184 | — | 0.201 | — | 0.217 | — | ns |
| t _{HLSR_PIO} | Set/Reset Hold Time | -0.080 | — | -0.086 | — | -0.093 | — | ns |
| EBR Timing | | | | | | | | |
| t _{CO_EBR} | Clock (Read) to output from Address or Data | — | 2.51 | — | 2.75 | — | 2.99 | ns |
| t _{COO_EBR} | Clock (Write) to output from EBR output Register | — | 0.33 | — | 0.36 | — | 0.39 | ns |
| t _{SUDATA_EBR} | Setup Data to EBR Memory | -0.157 | — | -0.181 | — | -0.205 | — | ns |
| t _{HDATA_EBR} | Hold Data to EBR Memory | 0.173 | — | 0.195 | — | 0.217 | — | ns |
| t _{SUADDR_EBR} | Setup Address to EBR Memory | -0.115 | — | -0.130 | — | -0.145 | — | ns |
| t _{HADDR_EBR} | Hold Address to EBR Memory | 0.138 | — | 0.155 | — | 0.172 | — | ns |
| t _{SUWREN_EBR} | Setup Write/Read Enable to PFU Memory | -0.128 | — | -0.149 | — | -0.170 | — | ns |

LatticeECP2/M Internal Switching Characteristics¹ (Continued)

Over Recommended Operating Conditions

| Parameter | Description | -7 | | -6 | | -5 | | Units |
|---------------------------------------|---|--------|------|--------|------|--------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t _{HWREN_EBR} | Hold Write/Read Enable to PFU Memory | 0.139 | — | 0.156 | — | 0.173 | — | ns |
| t _{SUCE_EBR} | Clock Enable Setup Time to EBR Output Register | 0.123 | — | 0.134 | — | 0.145 | — | ns |
| t _{HCE_EBR} | Clock Enable Hold Time to EBR Output Register | -0.081 | — | -0.090 | — | -0.100 | — | ns |
| t _{RSTO_EBR} | Reset To Output Delay Time from EBR Output Register | — | 1.03 | — | 1.15 | — | 1.26 | ns |
| t _{SUBE_EBR} | Byte Enable Set-Up Time to EBR Output Register | -0.115 | — | -0.130 | — | -0.145 | — | ns |
| t _{HBE_EBR} | Byte Enable Hold Time to EBR Output Register | 0.138 | — | 0.155 | — | 0.172 | — | ns |
| GPLL Parameters | | | | | | | | |
| t _{RSTREC_GPLL} | Reset Recovery to Rising Clock | 1.00 | — | 1.00 | — | 1.00 | — | ns |
| SPLL Parameters | | | | | | | | |
| t _{RSTREC_SPLL} | Reset Recovery to Rising Clock | 1.00 | — | 1.00 | — | 1.00 | — | ns |
| DSP Block Timing^{2,3} | | | | | | | | |
| t _{SUI_DSP} | Input Register Setup Time | 0.12 | — | 0.13 | — | 0.14 | — | ns |
| t _{HI_DSP} | Input Register Hold Time | 0.02 | — | -0.01 | — | -0.03 | — | ns |
| t _{SUP_DSP} | Pipeline Register Setup Time | 2.18 | — | 2.42 | — | 2.66 | — | ns |
| t _{IHP_DSP} | Pipeline Register Hold Time | -0.68 | — | -0.77 | — | -0.86 | — | ns |
| t _{SUO_DSP} | Output Register Setup Time | 4.26 | — | 4.71 | — | 5.16 | — | ns |
| t _{HO_DSP} | Output Register Hold Time | -1.25 | — | -1.40 | — | -1.54 | — | ns |
| t _{COI_DSP} | Input Register Clock to Output Time | — | 3.92 | — | 4.30 | — | 4.68 | ns |
| t _{COP_DSP} | Pipeline Register Clock to Output Time | — | 1.87 | — | 1.98 | — | 2.08 | ns |
| t _{COO_DSP} | Output Register Clock to Output Time | — | 0.50 | — | 0.52 | — | 0.55 | ns |
| t _{SUADDSUB} | AddSub Input Register Setup Time | -0.24 | — | -0.26 | — | -0.28 | — | ns |
| t _{HADDSUB} | AddSub Input Register Hold Time | 0.27 | — | 0.29 | — | 0.32 | — | ns |

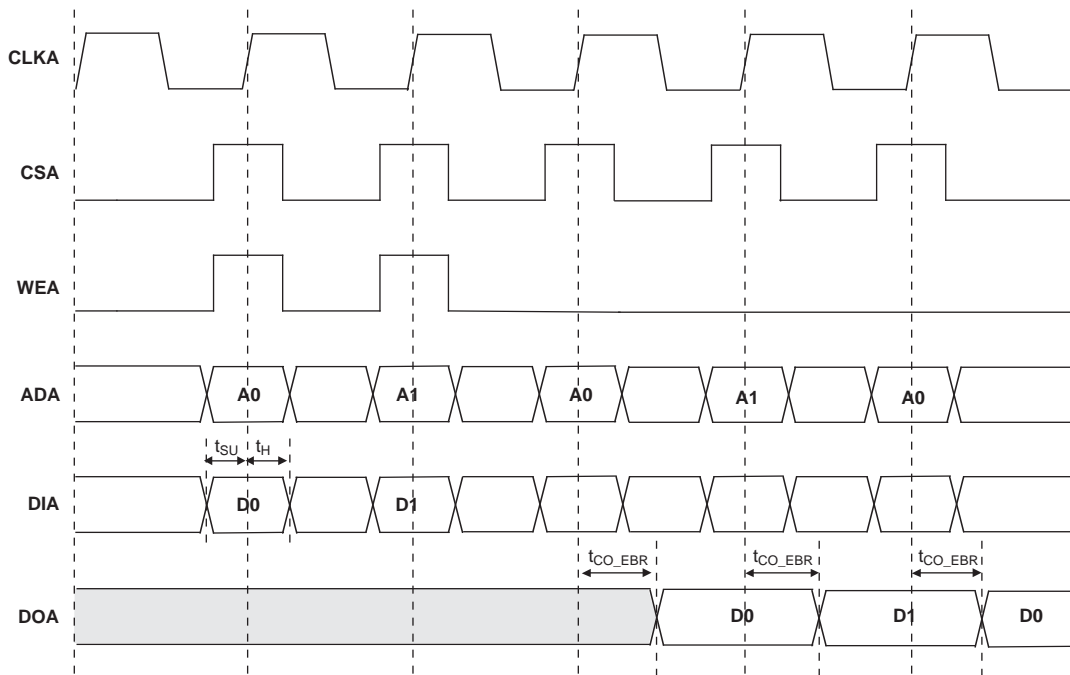
1. Internal parameters are characterized but not tested on every device.

2. These parameters apply to LatticeECP devices only.

3. DSP Block is configured in Multiply Add/Sub 18x18 Mode.

Timing Diagrams

Figure 3-9. Read/Write Mode (Normal)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

Figure 3-10. Read/Write Mode with Input and Output Registers

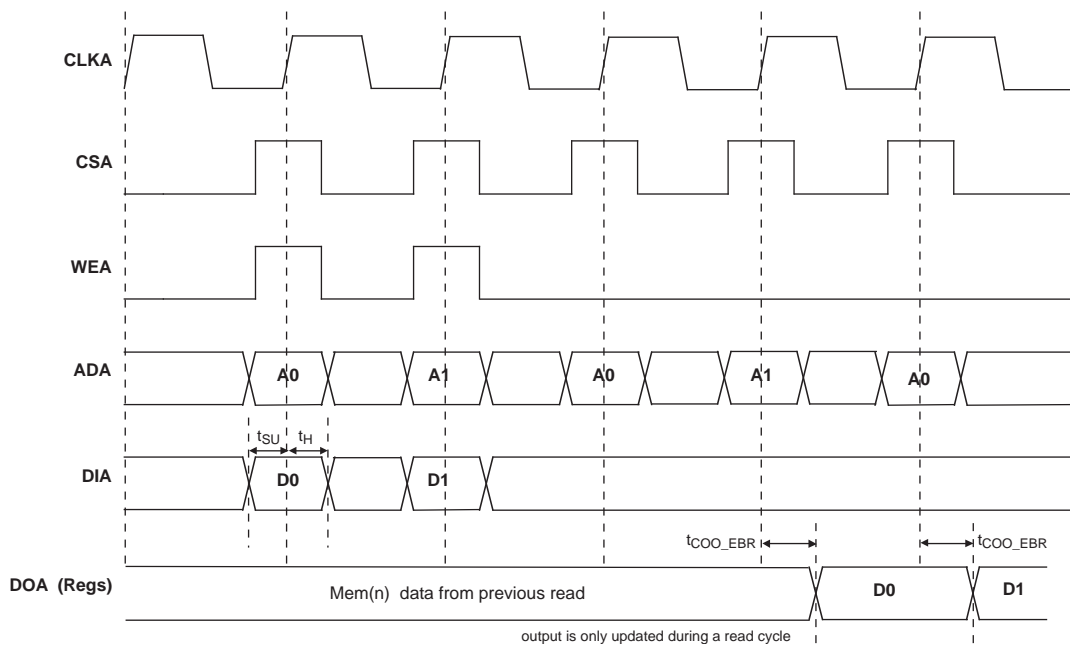
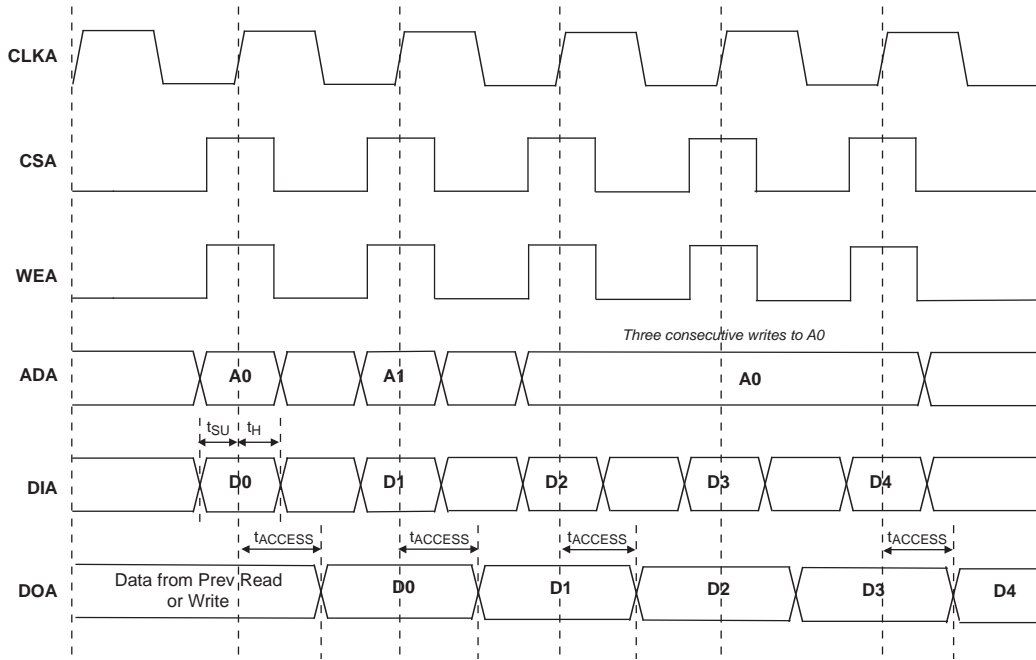


Figure 3-11. Write Through (SP Read/Write on Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

LatticeECP2/M Family Timing Adders^{1, 2, 3}

Over Recommended Operating Conditions

| Buffer Type | Description | -7 | -6 | -5 | Units |
|-------------------------|--|-------|-------|-------|-------|
| Input Adjusters | | | | | |
| LVDS25 | LVDS | -0.04 | -0.02 | 0.00 | ns |
| BLVDS25 | BLVDS | -0.04 | -0.09 | -0.15 | ns |
| MLVDS | LVDS | -0.15 | -0.15 | -0.15 | ns |
| RSDS | RSDS | -0.15 | -0.15 | -0.15 | ns |
| LVPECL33 | LVPECL | 0.16 | 0.15 | 0.13 | ns |
| HSTL18_I | HSTL_18 class I | 0.01 | -0.01 | -0.04 | ns |
| HSTL18_II | HSTL_18 class II | 0.01 | -0.01 | -0.04 | ns |
| HSTL18D_I | Differential HSTL 18 class I | 0.01 | -0.01 | -0.04 | ns |
| HSTL18D_II | Differential HSTL 18 class II | 0.01 | -0.01 | -0.04 | ns |
| HSTL15_I | HSTL_15 class I | 0.01 | -0.01 | -0.04 | ns |
| HSTL15D_I | Differential HSTL 15 class I | 0.01 | -0.01 | -0.04 | ns |
| SSTL33_I | SSTL_3 class I | -0.03 | -0.07 | -0.10 | ns |
| SSTL33_II | SSTL_3 class II | -0.03 | -0.07 | -0.10 | ns |
| SSTL33D_I | Differential SSTL_3 class I | -0.03 | -0.07 | -0.10 | ns |
| SSTL33D_II | Differential SSTL_3 class II | -0.03 | -0.07 | -0.10 | ns |
| SSTL25_I | SSTL_2 class I | -0.04 | -0.07 | -0.10 | ns |
| SSTL25_II | SSTL_2 class II | -0.04 | -0.07 | -0.10 | ns |
| SSTL25D_I | Differential SSTL_2 class I | -0.04 | -0.07 | -0.10 | ns |
| SSTL25D_II | Differential SSTL_2 class II | -0.04 | -0.07 | -0.10 | ns |
| SSTL18_I | SSTL_18 class I | -0.01 | -0.04 | -0.07 | ns |
| SSTL18_II | SSTL_18 class II | -0.01 | -0.04 | -0.07 | ns |
| SSTL18D_I | Differential SSTL_18 class I | -0.01 | -0.04 | -0.07 | ns |
| SSTL18D_II | Differential SSTL_18 class II | -0.01 | -0.04 | -0.07 | ns |
| LVTTTL33 | LVTTTL | -0.16 | -0.16 | -0.16 | ns |
| LVC MOS33 | LVC MOS 3.3 | -0.08 | -0.12 | -0.16 | ns |
| LVC MOS25 | LVC MOS 2.5 | 0.00 | 0.00 | 0.00 | ns |
| LVC MOS18 | LVC MOS 1.8 | -0.16 | -0.17 | -0.17 | ns |
| LVC MOS15 | LVC MOS 1.5 | -0.14 | -0.14 | -0.14 | ns |
| LVC MOS12 | LVC MOS 1.2 | -0.04 | -0.01 | 0.01 | ns |
| PCI33 | PCI | -0.08 | -0.12 | -0.16 | ns |
| Output Adjusters | | | | | |
| LVDS25E | LVDS 2.5 E ⁴ | 0.25 | 0.19 | 0.13 | ns |
| LVDS25 | LVDS 2.5 | 0.10 | 0.13 | 0.17 | ns |
| BLVDS25 | BLVDS 2.5 | 0.00 | -0.01 | -0.03 | ns |
| MLVDS | MLVDS 2.5 ⁴ | 0.00 | -0.01 | -0.03 | ns |
| RSDS | RSDS 2.5 ⁴ | 0.25 | 0.19 | 0.13 | ns |
| LVPECL33 | LVPECL 3.3 ⁴ | -0.02 | -0.04 | -0.06 | ns |
| HSTL18_I | HSTL_18 class I 8mA drive | -0.19 | -0.22 | -0.25 | ns |
| HSTL18_II | HSTL_18 class II | -0.30 | -0.34 | -0.37 | ns |
| HSTL18D_I | Differential HSTL 18 class I 8mA drive | -0.19 | -0.22 | -0.25 | ns |
| HSTL18D_II | Differential HSTL 18 class II | -0.30 | -0.34 | -0.37 | ns |

LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)

Over Recommended Operating Conditions

| Buffer Type | Description | -7 | -6 | -5 | Units |
|----------------|--|-------|-------|-------|-------|
| HSTL15_I | HSTL_15 class I 4mA drive | -0.22 | -0.25 | -0.27 | ns |
| HSTL15D_I | Differential HSTL 15 class I 4mA drive | -0.22 | -0.25 | -0.27 | ns |
| SSTL33_I | SSTL_3 class I | -0.12 | -0.15 | -0.18 | ns |
| SSTL33_II | SSTL_3 class II | -0.20 | -0.23 | -0.27 | ns |
| SSTL33D_I | Differential SSTL_3 class I | -0.12 | -0.15 | -0.18 | ns |
| SSTL33D_II | Differential SSTL_3 class II | -0.20 | -0.23 | -0.27 | ns |
| SSTL25_I | SSTL_2 class I 8mA drive | -0.16 | -0.19 | -0.22 | ns |
| SSTL25_II | SSTL_2 class II 16mA drive | -0.19 | -0.22 | -0.25 | ns |
| SSTL25D_I | Differential SSTL_2 class I 8mA drive | -0.16 | -0.19 | -0.22 | ns |
| SSTL25D_II | Differential SSTL_2 class II 16mA drive | -0.19 | -0.22 | -0.25 | ns |
| SSTL18_I | SSTL_1.8 class I | -0.14 | -0.17 | -0.20 | ns |
| SSTL18_II | SSTL_1.8 class II 8mA drive | -0.20 | -0.23 | -0.25 | ns |
| SSTL18D_I | Differential SSTL_1.8 class I | -0.14 | -0.17 | -0.20 | ns |
| SSTL18D_II | Differential SSTL_1.8 class II 8mA drive | -0.20 | -0.23 | -0.25 | ns |
| LVTTTL33_4mA | LVTTTL 4mA drive | 0.52 | 0.60 | 0.68 | ns |
| LVTTTL33_8mA | LVTTTL 8mA drive | 0.06 | 0.08 | 0.09 | ns |
| LVTTTL33_12mA | LVTTTL 12mA drive | 0.04 | 0.04 | 0.05 | ns |
| LVTTTL33_16mA | LVTTTL 16mA drive | 0.03 | 0.02 | 0.02 | ns |
| LVTTTL33_20mA | LVTTTL 20mA drive | -0.09 | -0.09 | -0.10 | ns |
| LVC MOS33_4mA | LVC MOS 3.3 4mA drive, fast slew rate | 0.52 | 0.60 | 0.68 | ns |
| LVC MOS33_8mA | LVC MOS 3.3 8mA drive, fast slew rate | 0.06 | 0.08 | 0.09 | ns |
| LVC MOS33_12mA | LVC MOS 3.3 12mA drive, fast slew rate | 0.04 | 0.04 | 0.05 | ns |
| LVC MOS33_16mA | LVC MOS 3.3 16mA drive, fast slew rate | 0.03 | 0.02 | 0.02 | ns |
| LVC MOS33_20mA | LVC MOS 3.3 20mA drive, fast slew rate | -0.09 | -0.09 | -0.10 | ns |
| LVC MOS25_4mA | LVC MOS 2.5 4mA drive, fast slew rate | 0.41 | 0.47 | 0.53 | ns |
| LVC MOS25_8mA | LVC MOS 2.5 8mA drive, fast slew rate | 0.01 | 0.01 | 0.00 | ns |
| LVC MOS25_12mA | LVC MOS 2.5 12mA drive, fast slew rate | 0.00 | 0.00 | 0.00 | ns |
| LVC MOS25_16mA | LVC MOS 2.5 16mA drive, fast slew rate | 0.04 | 0.04 | 0.04 | ns |
| LVC MOS25_20mA | LVC MOS 2.5 20mA drive, fast slew rate | -0.09 | -0.10 | -0.11 | ns |
| LVC MOS18_4mA | LVC MOS 1.8 4mA drive, fast slew rate | 0.37 | 0.40 | 0.43 | ns |
| LVC MOS18_8mA | LVC MOS 1.8 8mA drive, fast slew rate | 0.10 | 0.12 | 0.13 | ns |
| LVC MOS18_12mA | LVC MOS 1.8 12mA drive, fast slew rate | -0.02 | -0.02 | -0.02 | ns |
| LVC MOS18_16mA | LVC MOS 1.8 16mA drive, fast slew rate | -0.02 | -0.03 | -0.03 | ns |
| LVC MOS15_4mA | LVC MOS 1.5 4mA drive, fast slew rate | 0.29 | 0.31 | 0.32 | ns |
| LVC MOS15_8mA | LVC MOS 1.5 8mA drive, fast slew rate | 0.05 | 0.05 | 0.06 | ns |
| LVC MOS12_2mA | LVC MOS 1.2 2mA drive, fast slew rate | 0.58 | 0.69 | 0.79 | ns |
| LVC MOS12_6mA | LVC MOS 1.2 6mA drive, fast slew rate | 0.13 | 0.19 | 0.26 | ns |
| LVC MOS33_4mA | LVC MOS 3.3 4mA drive, slow slew rate | 2.17 | 2.44 | 2.71 | ns |
| LVC MOS33_8mA | LVC MOS 3.3 8mA drive, slow slew rate | 2.50 | 2.67 | 2.83 | ns |
| LVC MOS33_12mA | LVC MOS 3.3 12mA drive, slow slew rate | 1.72 | 1.88 | 2.05 | ns |
| LVC MOS33_16mA | LVC MOS 3.3 16mA drive, slow slew rate | 1.64 | 1.63 | 1.62 | ns |
| LVC MOS33_20mA | LVC MOS 3.3 20mA drive, slow slew rate | 1.33 | 1.36 | 1.39 | ns |

LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)

Over Recommended Operating Conditions

| Buffer Type | Description | -7 | -6 | -5 | Units |
|----------------|--|------|------|------|-------|
| LVC MOS25_4mA | LVC MOS 2.5 4mA drive, slow slew rate | 2.18 | 2.26 | 2.33 | ns |
| LVC MOS25_8mA | LVC MOS 2.5 8mA drive, slow slew rate | 2.19 | 2.35 | 2.51 | ns |
| LVC MOS25_12mA | LVC MOS 2.5 12mA drive, slow slew rate | 1.50 | 1.66 | 1.82 | ns |
| LVC MOS25_16mA | LVC MOS 2.5 16mA drive, slow slew rate | 1.60 | 1.59 | 1.58 | ns |
| LVC MOS25_20mA | LVC MOS 2.5 20mA drive, slow slew rate | 1.43 | 1.39 | 1.34 | ns |
| LVC MOS18_4mA | LVC MOS 1.8 4mA drive, slow slew rate | 2.22 | 2.27 | 2.32 | ns |
| LVC MOS18_8mA | LVC MOS 1.8 8mA drive, slow slew rate | 1.93 | 2.08 | 2.23 | ns |
| LVC MOS18_12mA | LVC MOS 1.8 12mA drive, slow slew rate | 1.43 | 1.51 | 1.58 | ns |
| LVC MOS18_16mA | LVC MOS 1.8 16mA drive, slow slew rate | 1.47 | 1.46 | 1.45 | ns |
| LVC MOS15_4mA | LVC MOS 1.5 4mA drive, slow slew rate | 2.32 | 2.38 | 2.43 | ns |
| LVC MOS15_8mA | LVC MOS 1.5 8mA drive, slow slew rate | 1.84 | 1.98 | 2.12 | ns |
| LVC MOS12_2mA | LVC MOS 1.2 2mA drive, slow slew rate | 2.52 | 2.63 | 2.74 | ns |
| LVC MOS12_6mA | LVC MOS 1.2 6mA drive, slow slew rate | 1.69 | 1.83 | 1.96 | ns |
| PCI33 | PCI33 | 0.04 | 0.04 | 0.04 | ns |

1. Timing Adders are characterized but not tested on every device.
 2. LVC MOS timing measured with the load specified in Switching Test Condition table.
 3. All other standards tested according to the appropriate specifications.
 4. These timing adders are measured with the recommended resistor values.
- Timing v.A 0.11

sysCLOCK GPLL Timing

Over Recommended Operating Conditions

| Parameter | Description | Conditions | Min. | Typ. | Max. | Units |
|---------------------------------|---------------------------------------|--|-------|------|-------|-------|
| f _{IN} | Input Clock Frequency (CLKI, CLKFB) | Without external capacitor | 20 | — | 420 | MHz |
| | | With external capacitor ^{5, 6} | 2 | — | 420 | MHz |
| f _{OUT} | Output Clock Frequency (CLKOP, CLKOS) | Without external capacitor | 20 | — | 420 | MHz |
| | | With external capacitor ⁵ | 5 | — | 50 | MHz |
| f _{OUT2} | K-Divider Output Frequency (CLKOK) | Without external capacitor | 0.156 | — | 210 | MHz |
| | | With external capacitor ⁵ | 0.039 | — | 25 | MHz |
| f _{VCO} | PLL VCO Frequency | | 640 | — | 1280 | MHz |
| f _{PDF} | Phase Detector Input Frequency | Without external capacitor | 20 | — | 420 | MHz |
| | | With external capacitor ^{5, 6} | 2 | — | 50 | MHz |
| AC Characteristics | | | | | | |
| t _{DT} | Output Clock Duty Cycle | Default duty cycle selected ³ | 45 | 50 | 55 | % |
| t _{PH} ⁴ | Output Phase Accuracy | | — | — | ±0.05 | UI |
| t _{OPJIT} ¹ | Output Clock Period Jitter | f _{OUT} ≥ 100 MHz | — | — | ±125 | ps |
| | | 50 ≤ f _{OUT} < 100 MHz | — | — | 0.025 | UIPP |
| | | f _{OUT} < 50 MHz | — | — | 0.04 | UIPP |
| t _{SK} | Input Clock to Output Clock Skew | N/M = integer | — | — | ±250 | ps |
| t _W | Output Clock Pulse Width | At 90% or 10% | 1 | — | — | ns |
| t _{LOCK} ² | PLL Lock-in Time | Without external capacitor | — | — | 150 | μs |
| | | With external capacitor ⁵ | — | — | 500 | μs |
| t _{PA} | Programmable Delay Unit | | 85 | 130 | 360 | ps |
| t _{IPJIT} | Input Clock Period Jitter | | — | — | ±200 | ps |
| t _{FBKDLY} | External Feedback Delay | | — | — | 10 | ns |
| t _{HI} | Input Clock High Time | 90% to 90% | 0.5 | — | — | ns |
| t _{LO} | Input Clock Low Time | 10% to 10% | 0.5 | — | — | ns |
| t _{RST} | RST Pulse Width (RESETM/RESETK) | | 15 | — | — | ns |
| | Reset Signal Pulse Width (CNTRST) | Without external capacitor | 500 | — | — | ns |
| | | With external capacitor ⁵ | 20 | — | — | μs |

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.

2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.

3. Using LVDS output buffers.

4. Relative to CLKOP.

5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.

6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

sysCLOCK SPLL Timing**Over Recommended Operating Conditions**

| Parameter | Description | Conditions | Min. | Typ. | Max. | Units |
|---------------------------------|---------------------------------------|--|-------|------|-------|-------|
| f _{IN} | Input Clock Frequency (CLKI, CLKFB) | Without external capacitor | 33 | — | 420 | MHz |
| | | With external capacitor ^{5, 6} | 2 | — | 420 | MHz |
| f _{OUT} | Output Clock Frequency (CLKOP, CLKOS) | Without external capacitor | 33 | — | 420 | MHz |
| | | With external capacitor ⁵ | 5 | — | 50 | MHz |
| f _{OUT2} | K-Divider Output Frequency (CLKOK) | Without external capacitor | 0.258 | — | 210 | MHz |
| | | With external capacitor ⁵ | 0.039 | — | 25 | MHz |
| f _{VCO} | PLL VCO Frequency | | 640 | — | 1280 | MHz |
| f _{PDF} | Phase Detector Input Frequency | Without external capacitor | 33 | — | 420 | MHz |
| | | With external capacitor ⁶ | 2 | — | 50 | MHz |
| AC Characteristics | | | | | | |
| t _{DT} | Output Clock Duty Cycle | Default Duty Cycle Selected ³ | 45 | 50 | 55 | % |
| t _{PH} ⁴ | Output Phase Accuracy | | — | — | ±0.05 | UI |
| t _{OPJIT} ¹ | Output Clock Period Jitter | f _{OUT} ≥ 100 MHz | — | — | ±125 | ps |
| | | 50 ≤ f _{OUT} < 100 MHz | — | — | 0.025 | UIPP |
| | | f _{OUT} < 50 MHz | — | — | 0.04 | UIPP |
| t _{SK} | Input Clock to Output Clock Skew | Divider Ratio = Integer | — | — | ±250 | ps |
| t _W | Output Clock Pulse Width | At 90% or 10% | 1 | — | — | ns |
| t _{LOCK} ² | PLL Lock-in Time | Without external capacitor | — | — | 150 | μs |
| | | With external capacitor ⁵ | — | — | 500 | μs |
| t _{IPJIT} | Input Clock Period Jitter | | — | — | ±200 | ps |
| t _{FBKDLY} | External Feedback Delay | | — | — | 10 | ns |
| t _{HI} | Input Clock High Time | 90% to 90% | 0.5 | — | — | ns |
| t _{LO} | Input Clock Low Time | 10% to 10% | 0.5 | — | — | ns |
| t _{RST} | RST Pulse Width (RESETM/RESETK) | | 15 | — | — | ns |
| | Reset Signal Pulse Width (CNTRST) | Without external capacitor | 500 | — | — | ns |
| | | With external capacitor ⁵ | 20 | — | — | μs |

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.

2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.

3. Using LVDS output buffers.

4. Phase accuracy of CLKOS compared to CLKOP.

5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.

6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

DLL Timing**Over Recommended Operating Conditions**

| Parameter | Description | Min. | Typ. | Max. | Units |
|---------------|---|--------|------|--------|--------|
| f_{REF} | Input reference clock frequency (on-chip or off-chip) | 100 | — | 500 | MHz |
| f_{FB} | Feedback clock frequency (on-chip or off-chip) | 100 | — | 500 | MHz |
| f_{CLKOP}^1 | Output clock frequency, CLKOP | 100 | — | 500 | MHz |
| f_{CLKOS}^2 | Output clock frequency, CLKOS | 25 | — | 500 | MHz |
| t_{PJIT} | Output clock period jitter (clean input) | | — | 250 | ps p-p |
| t_{CYJIT} | Output clock cycle to cycle jitter (clean input) | | | 250 | ps p-p |
| t_{DUTY} | Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode) | 35 | | 65 | % |
| $t_{DUTYTRD}$ | Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode) | 40 | | 60 | % |
| $t_{DUTYCIR}$ | Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode) | 40 | | 60 | % |
| t_{SKEW}^3 | Output clock to clock skew between two outputs with the same phase setting | — | — | 100 | ps |
| t_{PWH} | Input clock minimum pulse width high (at 80% level) | 750 | — | — | ps |
| t_{PWL} | Input clock minimum pulse width low (at 20% level) | 750 | — | — | ps |
| t_{INSTB} | Input clock period jitter | — | — | +/-250 | ps |
| t_{LOCK} | DLL lock time | 18,500 | — | — | cycles |
| t_{RSWD} | Digital reset minimum pulse width (at 80% level) | 3 | — | — | ns |
| t_{PA} | Delay step size | 16.5 | 42 | 59.4 | ps |
| t_{RANGE1} | Max. delay setting for single delay block (144 taps) | 2.376 | 6 | 8.553 | ns |
| t_{RANGE4} | Max. delay setting for four chained delay blocks | 9.504 | 24 | 34.214 | ns |

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)^{1, 2}**Table 3-7. Serial Output Timing and Levels**

| Symbol | Description | Frequency | Min. | Typ. | Max. | Units |
|-------------------------------|---|--------------------|--------------------------|--------------------------|--------------------------|--------|
| V _{TX-DIFF-P-P-1} | Differential swing (1V setting) ^{1, 2} | 0.25 to 3.125 Gbps | 0.79 | 0.99 | 1.19 | V, p-p |
| V _{TX-DIFF-P-P-1.25} | Differential swing (1.25V setting) ^{1, 2} | 0.25 to 3.125 Gbps | 1.00 | 1.25 | 1.50 | V, p-p |
| V _{TX-DIFF-P-P-1.3} | Differential swing (1.3V setting) ^{1, 2} | 0.25 to 3.125 Gbps | 1.04 | 1.30 | 1.56 | V, p-p |
| V _{TX-DIFF-P-P-1.35} | Differential swing (1.35V setting) ^{1, 2} | 0.25 to 3.125 Gbps | 1.08 | 1.35 | 1.62 | V, p-p |
| V _{OCM} | Output common mode voltage | — | V _{CCOB} - 0.75 | V _{CCOB} - 0.60 | V _{CCOB} - 0.45 | V |
| T _{TX-R} | Rise time (20% to 80%) | — | — | 70 | — | ps |
| T _{TX-F} | Fall time (80% to 20%) | — | — | 70 | — | ps |
| Z _{TX-OI-SE} | Output impedance 50/75/HiZ K Ohms (single-ended) | — | — | 50/70 HiZ | — | Ohms |
| R _{TX-RL} | Return loss (with package) | — | — | 9 | — | dB |

1. All measurements are with 50 ohm impedance.

2. See TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#) for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

| Description | Frequency | Min. | Typ. | Max. | Units |
|---------------|------------|------|------|------|---------|
| Deterministic | 3.125 Gbps | — | 0.08 | 0.12 | UI, p-p |
| Random | 3.125 Gbps | — | 0.22 | 0.38 | UI, p-p |
| Total | 3.125 Gbps | — | 0.33 | 0.43 | UI, p-p |
| Deterministic | 2.5 Gbps | — | 0.08 | 0.17 | UI, p-p |
| Random | 2.5 Gbps | — | 0.20 | 0.25 | UI, p-p |
| Total | 2.5 Gbps | — | 0.25 | 0.35 | UI, p-p |
| Deterministic | 1.25 Gbps | — | 0.03 | 0.10 | UI, p-p |
| Random | 1.25 Gbps | — | 0.14 | 0.19 | UI, p-p |
| Total | 1.25 Gbps | — | 0.17 | 0.24 | UI, p-p |
| Deterministic | 250 Mbps | — | 0.04 | 0.17 | UI, p-p |
| Random | 250 Mbps | — | 0.12 | 0.13 | UI, p-p |
| Total | 250 Mbps | — | 0.15 | 0.29 | UI, p-p |

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

Table 3-9. Channel Output Jitter - x20 Mode

| Description | Frequency | Min. | Typ. | Max. | Units |
|---------------|------------|------|------|------|---------|
| Deterministic | 3.125 Gbps | — | 0.08 | 0.12 | UI, p-p |
| Random | 3.125 Gbps | — | 0.27 | 0.51 | UI, p-p |
| Total | 3.125 Gbps | — | 0.35 | 0.59 | UI, p-p |
| Deterministic | 2.5 Gbps | — | 0.09 | 0.19 | UI, p-p |
| Random | 2.5 Gbps | — | 0.23 | 0.34 | UI, p-p |
| Total | 2.5 Gbps | — | 0.29 | 0.45 | UI, p-p |
| Deterministic | 1.25 Gbps | — | 0.05 | 0.11 | UI, p-p |
| Random | 1.25 Gbps | — | 0.16 | 0.22 | UI, p-p |
| Total | 1.25 Gbps | — | 0.20 | 0.28 | UI, p-p |

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x20 mode.

Table 3-10. SERDES/PCS Latency Breakdown (Parallel Clock Cycle)

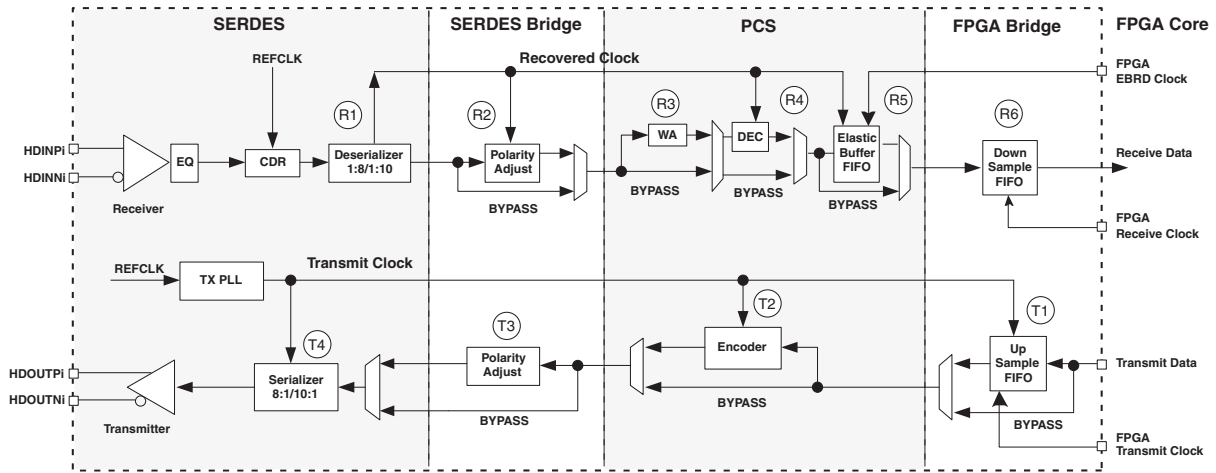
| Item | Description | Min. | Average | Max. | Fixed | Bypass | Units |
|------------------------------|-----------------------------------|------|---------|------|---------|--------|----------|
| Transmit Data Latency | | | | | | | |
| T1 | FPGA Bridge Transmit ² | 1 | 3 | 5 | | 1 | word clk |
| T2 | 8b10b Encoder | — | — | — | 2 | 1 | word clk |
| T3 | SERDES Bridge Transmit | — | — | — | 2 | 1 | word clk |
| T4 ³ | Serializer: 8-bit mode | — | — | — | 15 + Δ1 | — | UI + ps |
| | Serializer: 10-bit mode | — | — | — | 18 + Δ1 | — | UI + ps |
| Receive Data Latency | | | | | | | |
| R1 ³ | Deserializer: 8-bit mode | — | — | — | 10 + Δ2 | — | UI + ps |
| | Deserializer: 10-bit mode | — | — | — | 12 + Δ2 | — | UI + ps |
| R2 | SERDES Bridge Receive | — | — | — | 2 | 1 | word clk |
| R3 | Word Alignment | 3.1 | — | 4 | — | 0 | word clk |
| R4 | 8b10b Decoder | — | — | — | 1 | 1 | word clk |
| R5 | Clock Tolerance Compensation | 7 | 15 | 23 | | 1 | word clk |
| R6 | FPGA Bridge Receive ² | 1 | 3 | 5 | | 1 | word clk |

1. PCS internal parallel clock. This clock rate is the same as rxfullclk.

2. FPGA Bridge latency varies by the upsample/downsample FIFO read/write. The numbers given are for the 8b10b interface. The depth of the downsample/upsample FIFO is 4. The earliest read can be done after the write clock cycle (one clock) in downsample FIFO. The latest read will be done after the FIFO is full (4 + 1 = 5). For the 16b20b interface, the numbers are doubled: min. = 2, max. = 10. This latency depends on the internal FIFO flag operation.

3. Δ1 = -245ps, Δ2 = 700ps

Figure 3-12. Transmitter and Receiver Block Diagram



SERDES High Speed Data Receiver (LatticeECP2M Family Only)**Table 3-11. Serial Input Data Specifications**

| Symbol | Description | Min. | Typ. | Max. | Units |
|------------------------|---|------|----------------------------------|------------------------------------|---------|
| RX-CID _S | Stream of nontransitions ¹ (CID = Consecutive Identical Digits) @ 10 ⁻¹² BER | | 7 @ 3.125 Gbps 20 @ 1.25 Gbps | | Bits |
| V _{RX-DIFF-S} | Differential input sensitivity | 100 | — | — | mV, p-p |
| V _{RX-IN} | Input levels | 0 | — | V _{CCR_X} + 0.8 | V |
| V _{RX-CM-DC} | Input common mode range (DC coupled) | 0.5 | — | 1.2 | V |
| V _{RX-CM-AC} | Input common mode range (AC coupled) ³ | 0 | — | 1.5 | V |
| T _{RX-RELOCK} | CDR re-lock time ² | — | — | 3000 | Bits |
| Z _{RX-TERM} | Input termination 50/75 Ohm/High Z | — | 50 | | Ohms |
| RL _{RX-RL} | Return loss (without package) | — | 9 | — | dB |

1. This is the number of bits allowed without a transition on the incoming data stream when using DC coupling.
2. This is the typical number of bit times to re-lock to a new phase of frequency within +/- 300 ppm, assuming 8b10b encoded data and the CDR is in lock state. When CDR is in un-lock state, or reset is applied, the total re-lock settling time will be approximately 4ms including analog settle time, calibration time, and acquisition time.
3. AC coupling is used to interface to LVPECL and LVDS.

Input Data Jitter Tolerance

A receiver's ability to tolerate incoming signal jitter is very dependent on jitter type. High speed serial interface standards have recognized the dependency on jitter type and have recently modified specifications to indicate tolerance levels for different jitter types as they relate to specific protocols (e.g. FC, etc.). Sinusoidal jitter is considered to be a worst case jitter type.

Table 3-12. Receiver Total Jitter Tolerance Specification¹

| Description | Frequency | Condition | Min. | Typ. | Max. | Units |
|---------------|-----------------------|-------------------------|------|------|------|---------|
| Deterministic | 3.125 Gbps | 600 mV differential eye | — | — | 0.54 | UI, p-p |
| Random | | 600 mV differential eye | — | — | 0.26 | UI, p-p |
| Total | | 600 mV differential eye | — | — | 0.80 | UI, p-p |
| Deterministic | 2.5 Gbps | 600 mV differential eye | — | — | 0.61 | UI, p-p |
| Random | | 600 mV differential eye | — | — | 0.22 | UI, p-p |
| Total | | 600 mV differential eye | — | — | 0.81 | UI, p-p |
| Deterministic | 1.25 Gbps | 600 mV differential eye | — | — | 0.53 | UI, p-p |
| Random | | 600 mV differential eye | — | — | 0.22 | UI, p-p |
| Total | | 600 mV differential eye | — | — | 0.80 | UI, p-p |
| Deterministic | 250 Mbps ² | 600 mV differential eye | — | — | 0.42 | UI, p-p |
| Random | | 600 mV differential eye | — | — | 0.10 | UI, p-p |
| Total | | 600 mV differential eye | — | — | 0.60 | UI, p-p |

1. Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, voltages are nominal, room temperature.
2. Jitter specification is limited by measurement equipment capability.

Table 3-13. Periodic Receiver Jitter Tolerance Specification¹

| Description | Frequency | Condition | Min. | Typ. | Max. | Units |
|-------------|-----------------------|-------------------------|------|------|------|---------|
| Periodic | 3.125 Gbps | 600 mV differential eye | — | — | 0.20 | UI, p-p |
| | 2.5 Gbps | 600 mV differential eye | — | — | 0.22 | UI, p-p |
| | 1.25 Gbps | 600 mV differential eye | — | — | 0.20 | UI, p-p |
| | 250 Mbps ² | 600 mV differential eye | — | — | 0.08 | UI, p-p |

1. Values are measured with PRBS 2⁷-1, all channels operating.

2. Jitter specification is limited by measurement equipment capability.

SERDES External Reference Clock (LatticeECP2M Family Only)

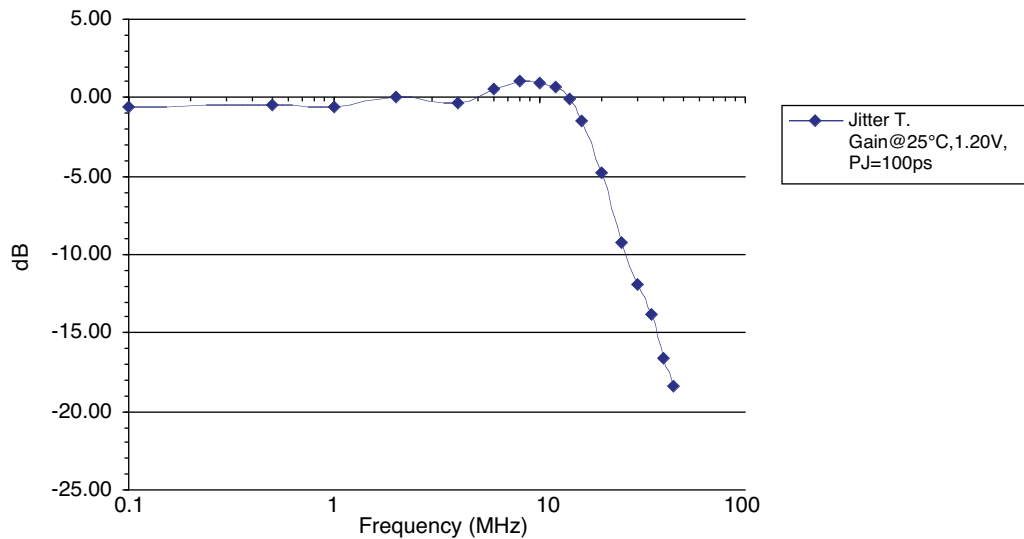
The external reference clock selection and its interface are a critical part of system applications for this product. Table 3-14 specifies reference clock requirements, over the full range of operating conditions.

Table 3-14. External Reference Clock Specification (refclkp/refclkn)

| Symbol | Description | Min. | Typ. | Max. | Units |
|--------------------------|---|------|-------|------------------------|---------|
| F _{REF} | Frequency range | 25 | — | 320 | MHz |
| F _{REF-PPM} | Frequency tolerance | -300 | — | 300 | ppm |
| V _{REF-IN-SE} | Input swing, single-ended clock ¹ | 100 | — | 1200 | mV, p-p |
| V _{REF-IN} | Input levels | 0 | — | V _{CCP} + 0.8 | V |
| V _{REF-CM-DC} | Input common mode range (DC coupled) | 0.5 | — | 1.2 | V |
| V _{REF-CM-AC} | Input common mode range (AC coupled) ² | 0 | — | 1.5 | V |
| D _{REF} | Duty cycle ³ | 40 | — | 60 | % |
| T _{REF-R} | Rise time (20% to 80%) | | 500 | 1000 | ps |
| T _{REF-F} | Fall time (80% to 20%) | | 500 | 1000 | ps |
| Z _{REF-IN-TERM} | Input termination | | 50/2K | | Ohms |
| C _{REF-IN-CAP} | Input capacitance ⁴ | — | — | 1.5 | pF |

1. The signal swing for a single-ended input clock must be as large as the p-p differential swing of a differential input clock to get the same gain at the input receiver. Lower swings for the clock may be possible, but will tend to increase jitter.
2. When AC coupled, the input common mode range is determined by:
(Min input level) + (Peak-to-peak input swing)/2 ≤ (Input common mode voltage) ≤ (Max input level) - (Peak-to-peak input swing)/2
3. Measured at 50% amplitude.
4. Input capacitance of 1.5pF is total capacitance, including both device and package.

Figure 3-13. Jitter Transfer



Note: This graph is for a nominal device.

SERDES Power-Down/Power-Up Specification

Table 3-15. Power-Down and Power-Up Specification

| Symbol | Description | Max. | Units |
|--------------------|---|------|-------|
| t _{PWRDN} | Power-down time after all power down register bits set to '0' | 10 | μs |
| t _{PWRUP} | Power-up time after all power down register bits set to '1' | 100 | μs |

PCI Express Electrical and Timing Characteristics

AC and DC Characteristics

Table 3-16. Transmit^{1,2}

| Symbol | Description | Test Conditions | Min | Typ | Max | Units |
|---|--|--|--------|------|-----------------------|-------|
| UI | Unit interval | | 399.88 | 400 | 400.12 | ps |
| V _{TX-DIFF_P-P} | Differential peak-to-peak output voltage | | 0.8 | 1.0 | 1.2 | V |
| V _{TX-DE-RATIO} | De-emphasis differential output voltage ratio | | 0 | -3.5 | -7.96 | dB |
| V _{TX-CM-AC_P} | RMS AC peak common-mode output voltage | | — | 20 | — | mV |
| V _{TX-CM-DC-LINE-DELTA} | Maximum Common mode voltage delta between n and p channels | | — | — | 25 | mV |
| V _{TX-DC-CM} | Tx DC common mode voltage | | 0 | — | V _{CCOB} +5% | V |
| I _{TX-SHORT} | Output short circuit current | V _{TX-D+} =0.0V V _{TX-D-} =0.0V | — | — | 90 | mA |
| Z _{TX-DIFF-DC} | Differential output impedance | | 80 | 100 | 120 | Ohms |
| T _{TX-RISE} | Tx output rise time | 20 to 80% | 0.125 | — | — | UI |
| T _{TX-FALL} | Tx output fall time | 20 to 80% | 0.125 | — | — | UI |
| L _{TX-SKEW} | Lane-to-lane static output skew for all lanes in port/link | | — | — | 1.3 | ns |
| T _{TX-EYE} | Transmitter eye width | | 0.75 | — | — | UI |
| T _{TX-EYE-MEDIAN-TO-MAX-JITTER} ³ | | | — | — | 0.125 | UI |
| C _{TX} | AC coupling capacitor | | 75 | — | 200 | nF |

1. Values are measured at 2.5 Gbps.

2. Compliant to PCI Express v1.1.

3. Measured at 60ps with plug-in board and jitter due to socket removed.

Table 3-17. Receive

| Symbol | Description | Test Conditions | Min. | Typ. | Max. | Units |
|--|---|-----------------|--------|------|--------|-------|
| UI | Unit Interval | | 399.88 | 400 | 400.12 | ps |
| V _{RX-DIFF_P-P} | Differential peak-to-peak input voltage | | 0.175 | — | — | V |
| V _{RX-IDLE-DET-DIFF_P-P} | Idle detect threshold voltage | | 65 | — | 175 | mV |
| Z _{RX-DIFF-DC} | DC differential input impedance | | 80 | 100 | 120 | Ohms |
| Z _{RX-DC} | DC input impedance | | 40 | 50 | 60 | Ohms |
| Z _{RX-HIGH-IMP-DC} ¹ | Power-down DC input impedance | | 200K | — | — | Ohms |
| T _{RX-EYE} | Receiver eye width | | 0.4 | — | — | UI |
| T _{RX-EYE-MEDIAN-TO-MAX-JITTER} | | | — | — | 0.3 | UI |

Notes:

1. Measured with external AC-coupling on the receiver

2. Values are measured at 2.5 Gbps

Table 3-18. Reference Clock

| Symbol | Description | Test Conditions | Min. | Typ. | Max. | Units |
|---------------|----------------------------------|-----------------|------|------|------|-------|
| F_{REFCLK} | Reference clock frequency | | — | 100 | — | MHz |
| V_{CM} | Input common mode voltage | | — | 0.65 | — | V |
| T_R/T_F | Clock input rise/fall time | | — | — | 1.0 | ns |
| V_{SW} | Differential input voltage swing | | 0.6 | — | 1.6 | V |
| DC_{REFCLK} | Input clock duty cycle | | 40 | 50 | 60 | % |
| PPM | Reference clock tolerance | | -300 | — | +300 | ppm |

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

| Parameter | Description | Min. | Max. | Units |
|--|---|----------|----------|--------|
| sysCONFIG Byte Data Flow | | | | |
| t _{SUCBDI} | Byte D[0:7] Setup Time to CCLK | 7 | — | ns |
| t _{HCBDI} | Byte D[0:7] Hold Time to CCLK | 1 | — | ns |
| t _{CODO} | CCLK to DOUT in Flowthrough Mode | — | 12 | ns |
| t _{SUCS} | CSN[0:1] Setup Time to CCLK | 7 | — | ns |
| t _{HCS} | CSN[0:1] Hold Time to CCLK | 1 | — | ns |
| t _{SUWD} | Write Signal Setup Time to CCLK | 7 | — | ns |
| t _{HWD} | Write Signal Hold Time to CCLK | 1 | — | ns |
| t _{DCB} | CCLK to BUSY Delay Time | — | 12 | ns |
| t _{CORD} | CCLK to Out for Read Data | — | 12 | ns |
| sysCONFIG Byte Slave Clocking | | | | |
| t _{BSCH} | Byte Slave CCLK Minimum High Pulse | 6 | — | ns |
| t _{BSCL} | Byte Slave CCLK Minimum Low Pulse | 9 | — | ns |
| t _{BSCYC} | Byte Slave CCLK Cycle Time | 15 | — | ns |
| sysCONFIG Serial (Bit) Data Flow | | | | |
| t _{SUSCDI} | DI Setup Time to CCLK Slave Mode | 7 | — | ns |
| t _{HSCDI} | DI Hold Time to CCLK Slave Mode | 1 | — | ns |
| t _{CODO} | CCLK to DOUT in Flowthrough Mode | — | 12 | ns |
| sysCONFIG Serial Slave Clocking | | | | |
| t _{SSCH} | Serial Slave CCLK Minimum High Pulse | 6 | — | ns |
| t _{SSCL} | Serial Slave CCLK Minimum Low Pulse | 6 | — | ns |
| sysCONFIG POR, Initialization and Wake-up | | | | |
| t _{ICFG} | Minimum Vcc to INITN High | — | 28 | ms |
| t _{VMC} | Time from t _{ICFG} to Valid Master CCLK | — | 2 | us |
| t _{PRGMRJ} | PROGRAMN Pin Pulse Rejection | — | 8 | ns |
| t _{PRGM} | PROGRAMN Low Time to Start Configuration | 25 | — | ns |
| t _{DINIT} | PROGRAMN High to INITN High Delay ¹ | — | 1.5 | ms |
| t _{DPPINIT} | Delay Time from PROGRAMN Low to INITN Low | — | 37 | ns |
| t _{DPPDONE} | Delay Time from PROGRAMN Low to DONE Low | — | 37 | ns |
| t _{IODISS} | User I/O Disable from PROGRAMN Low | — | 35 | ns |
| t _{IOENSS} | User I/O Enabled Time from CCLK Edge During Wake-up Sequence | — | 25 | ns |
| t _{MWC} | Additional Wake Master Clock Signals after DONE Pin High | 120 | — | cycles |
| sysCONFIG SPI Port² | | | | |
| t _{CFGX} | INITN High to CCLK Low | — | 1 | μs |
| t _{CSSPI} | INITN High to CSSPIN Low | — | 2 | us |
| t _{CSCCLK} | CCLK Low before CSSPIN Low | 0 | — | ns |
| t _{SOCDO} | CCLK Low to Output Valid | — | 15 | ns |
| t _{SOE} | CSSPIN[0:1] Active Setup Time | 300 | — | ns |
| t _{CSPID} | CSSPIN[0:1] Low to First CCLK Edge Setup Time | 300+3cyc | 600+6cyc | ns |
| f _{MAXSPI} | Max. CCLK Frequency - SPI Flash Read Opcode (0x03) (SPIFASTN = 1) | — | 20 | MHz |
| | Max. CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN = 0) | — | 50 | MHz |

LatticeECP2/M sysCONFIG Port Timing Specifications (Continued)

Over Recommended Operating Conditions

| Parameter | Description | Min. | Max. | Units |
|-------------|-----------------------------------|------|------|-------|
| t_{SUSPI} | SOSPI Data Setup Time Before CCLK | 7 | — | ns |
| t_{HSPI} | SOSPI Data Hold Time After CCLK | 2 | — | ns |

1. Re-toggling the PROGRAMN pin is not permitted until the INITN pin is high. Avoid consecutive toggling of the PROGRAMN.
2. For SED (Soft Error Detect), the SEDCLKIN operating frequency must be at least 20MHz. SEDCLKIN is derived from Master Clock Frequency that has a +/-30% variation..

| Parameter | Min. | Max. | Units |
|------------------------|----------------------|----------------------|-------|
| Master Clock Frequency | Selected value - 30% | Selected value + 30% | MHz |
| Duty Cycle | 40 | 60 | % |

Figure 3-14. sysCONFIG Parallel Port Read Cycle

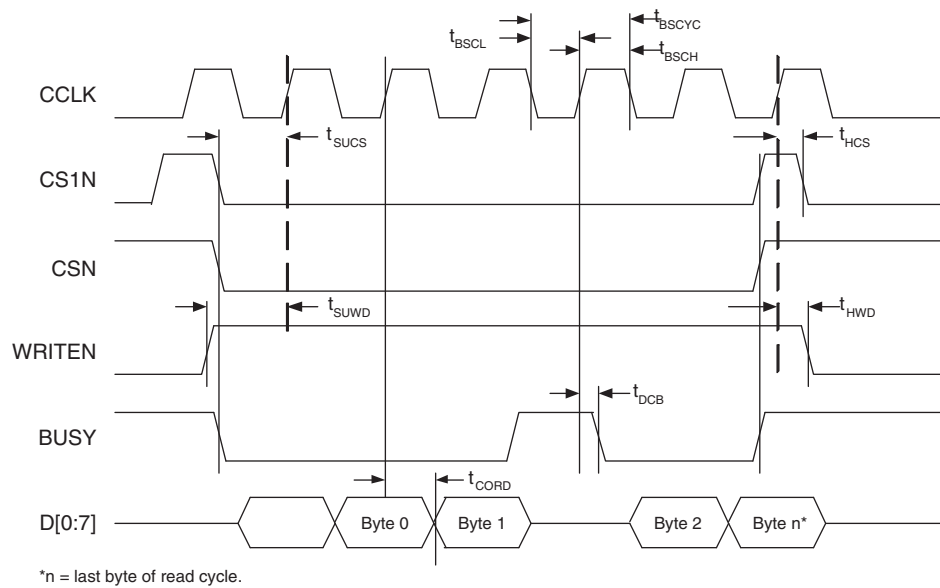
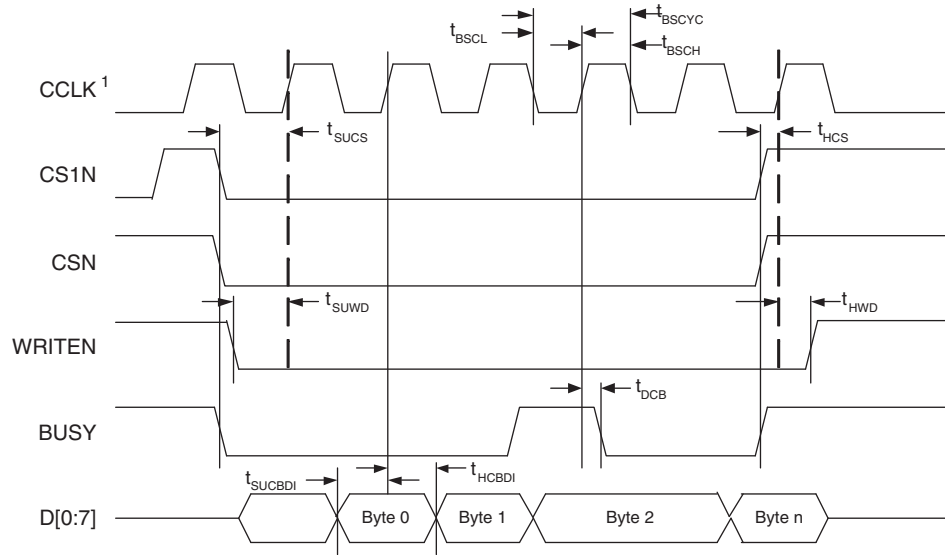


Figure 3-15. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-16. sysCONFIG Slave Serial Port Timing

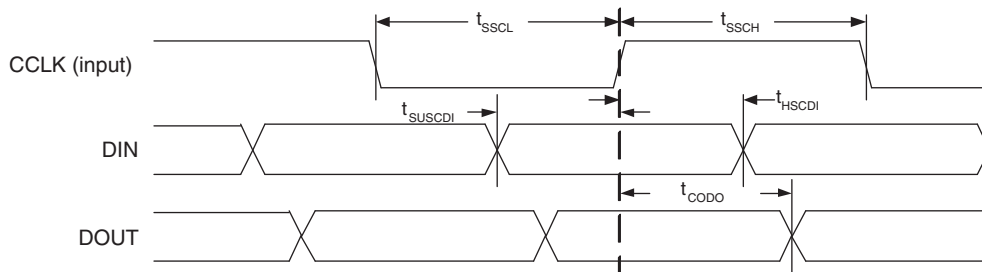
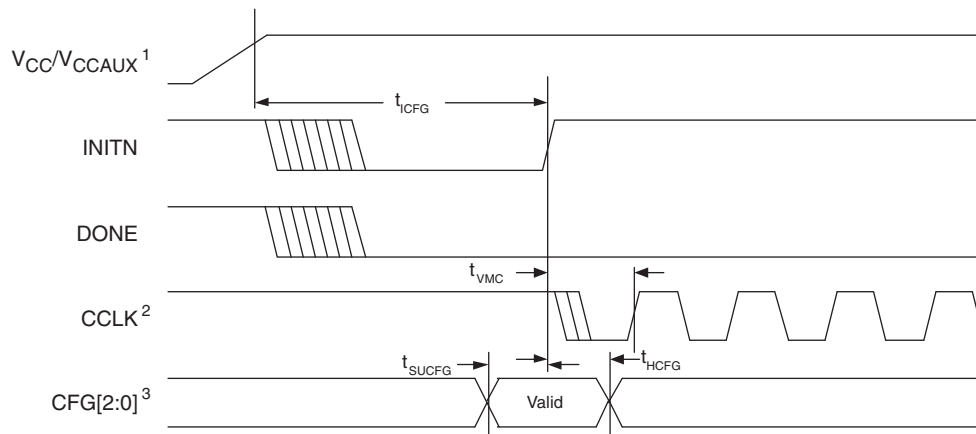
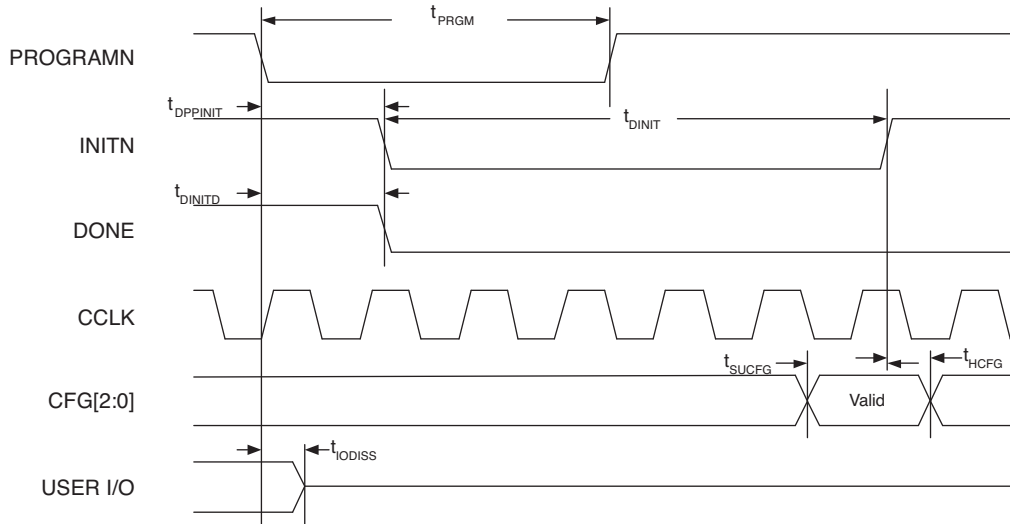


Figure 3-17. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX}, whichever is the last to reach its V_{MIN}.
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

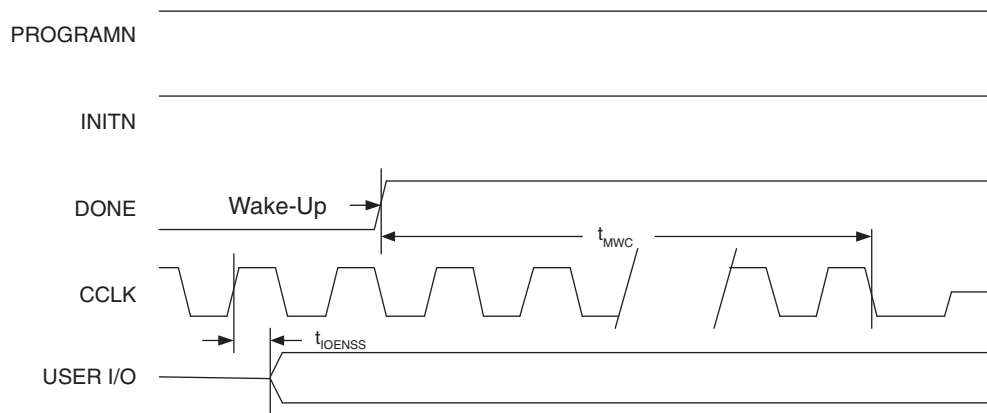
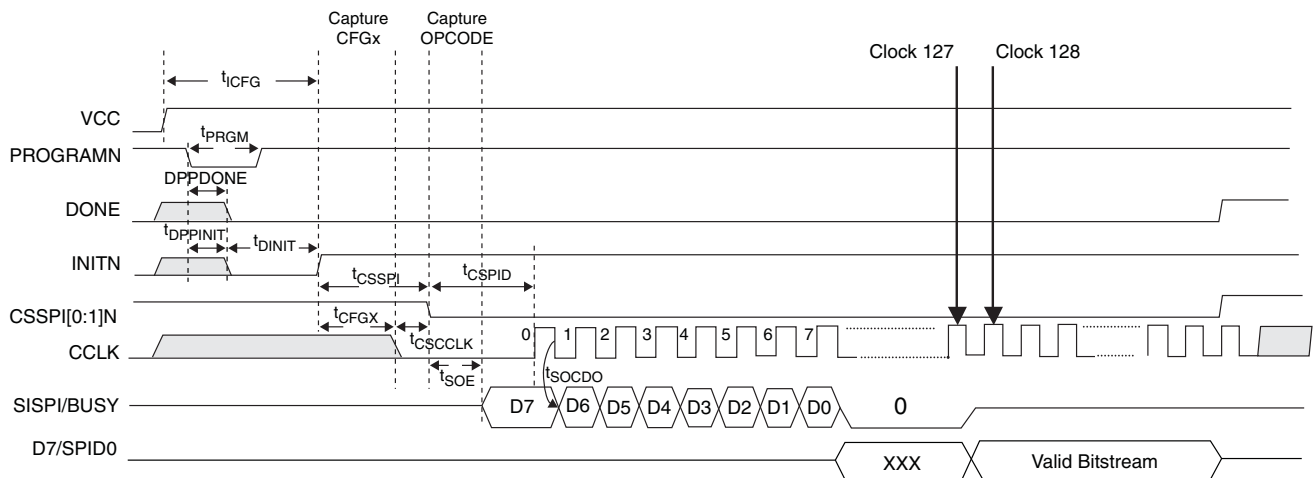


Figure 3-20. SPI/SPI_m Configuration Waveforms



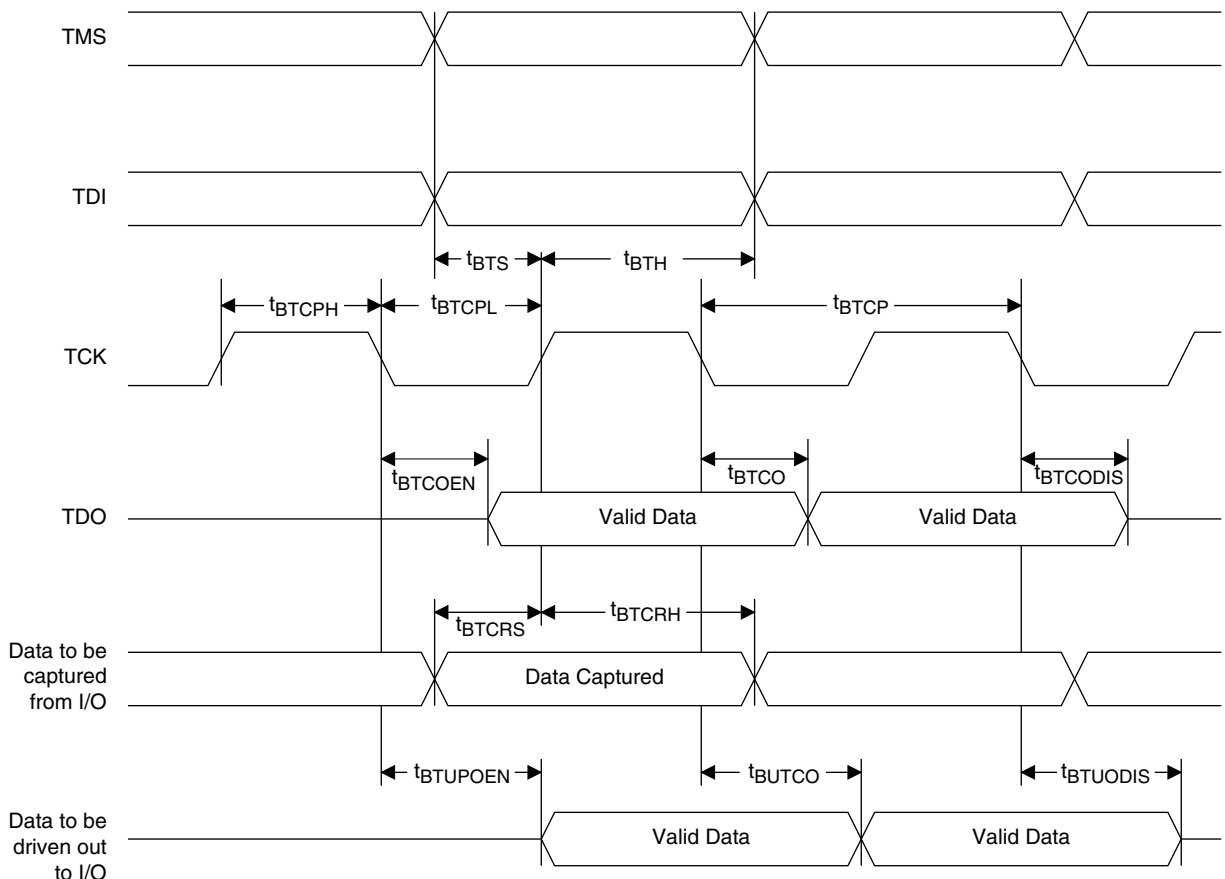
JTAG Port Timing Specifications

Over Recommended Operating Conditions

| Symbol | Parameter | Min | Max | Units |
|---------------|--|-----|-----|-------|
| f_{MAX} | TCK clock frequency | — | 25 | MHz |
| t_{BTCP} | TCK [BSCAN] clock pulse width | 40 | — | ns |
| t_{BTCPH} | TCK [BSCAN] clock pulse width high | 20 | — | ns |
| t_{BTCPL} | TCK [BSCAN] clock pulse width low | 20 | — | ns |
| t_{BTS} | TCK [BSCAN] setup time | 8 | — | ns |
| t_{BTH} | TCK [BSCAN] hold time | 10 | — | ns |
| t_{BTRF} | TCK [BSCAN] rise/fall time | 50 | — | mV/ns |
| t_{BTCO} | TAP controller falling edge of clock to valid output | — | 10 | ns |
| $t_{BTCODIS}$ | TAP controller falling edge of clock to valid disable | — | 10 | ns |
| t_{BTCOEN} | TAP controller falling edge of clock to valid enable | — | 10 | ns |
| t_{BTCRS} | BSCAN test capture register setup time | 8 | — | ns |
| t_{BTCRH} | BSCAN test capture register hold time | 25 | — | ns |
| t_{BUTCO} | BSCAN test update register, falling edge of clock to valid output | — | 25 | ns |
| $t_{BTUODIS}$ | BSCAN test update register, falling edge of clock to valid disable | — | 25 | ns |
| $t_{BTUPOEN}$ | BSCAN test update register, falling edge of clock to valid enable | — | 25 | ns |

Timing v.A 0.11

Figure 3-21. JTAG Port Timing Waveforms



Switching Test Conditions

Figure 3-22 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-19.

Figure 3-22. Output Test Load, LVTTTL and LVCMOS Standards



*CL Includes Test Fixture and Probe Capacitance

Table 3-19. Test Fixture Required Components, Non-Terminated Interfaces

| Test Condition | R ₁ | R ₂ | C _L | Timing Ref. | V _T |
|---|----------------|----------------|----------------|-----------------------------------|-------------------|
| LVTTTL and other LVCMOS settings (L -> H, H -> L) | ∞ | ∞ | 0pF | LVCMOS 3.3 = 1.5V | — |
| | | | | LVCMOS 2.5 = V _{CCIO} /2 | — |
| | | | | LVCMOS 1.8 = V _{CCIO} /2 | — |
| | | | | LVCMOS 1.5 = V _{CCIO} /2 | — |
| | | | | LVCMOS 1.2 = V _{CCIO} /2 | — |
| LVCMOS 2.5 I/O (Z -> H) | ∞ | 1MΩ | | V _{CCIO} /2 | — |
| LVCMOS 2.5 I/O (Z -> L) | 1MΩ | ∞ | | V _{CCIO} /2 | V _{CCIO} |
| LVCMOS 2.5 I/O (H -> Z) | ∞ | 100 | | V _{OH} - 0.10 | — |
| LVCMOS 2.5 I/O (L -> Z) | 100 | ∞ | | V _{OL} + 0.10 | V _{CCIO} |

Note: Output test conditions for all other interfaces are determined by the respective standards.

Signal Descriptions

| Signal Name | I/O | Description |
|--|-----|---|
| General Purpose | | |
| P[Edge] [Row/Column Number*]_[A/B] | I/O | <p>[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top).</p> <p>[Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number.</p> <p>[A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See “Typical sysI/O I/O Behavior During Power-up” for more information about I/O behavior during power-up.</p> |
| GSRN | I | Global RESET signal (active low). Any I/O pin can be GSRN. |
| NC | — | No connect. |
| GND | — | Ground. Dedicated pins. |
| V _{CC} | — | Power supply pins for core logic. Dedicated pins. |
| V _{CCAUX} | — | Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers. |
| V _{CCIOx} | — | Dedicated power supply pins for I/O bank x. |
| V _{CCPLL} | — | PLL supply pins. Should be tied to V _{CC} even when the corresponding PLL is unused. |
| V _{REF1_x} , V _{REF2_x} | — | Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins. |
| XRES ⁴ | — | 10K ohm +/-1% resistor must be connected between this pad and ground. |
| PLLCAP ⁴ | — | External capacitor connection for PLL. |
| PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins) | | |
| [LOC][num]_V _{CCPLL} | — | Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center. |
| [LOC][num]_GPLL[T, C]_IN_A | I | General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side. |
| [LOC][num]_GPLL[T, C]_FB_A | I | Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side. |
| [LOC][num]_SPLL[T, C]_IN_A ⁵ | I | Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side. |
| [LOC][num]_SPLL[T, C]_FB_A ⁵ | I | Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side. |
| [LOC][num]_DLL[T, C]_IN_A | I | DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side. |
| [LOC][num]_DLL[T, C]_FB_A | I | Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side. |
| PCLK[T, C]_[n:0]_[3:0] | I | Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank. |

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Signal Descriptions (Cont.)

| Signal Name | I/O | Description |
|---|-----|--|
| [LOC]DQS[num] | I/O | DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number. |
| [LOC]DQ[num] | I/O | DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number. |
| Test and Programming (Dedicated Pins) | | |
| TMS | I | Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration. |
| TCK | I | Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled. |
| TDI | I | Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration. |
| TDO | O | Output pin. Test Data Out pin used to shift data out of a device using 1149.1. |
| VCCJ | — | Power supply pin for JTAG Test Access Port. |
| Configuration Pads (Used During sysCONFIG) | | |
| CFG[2:0] | I | Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins. |
| INITN | I/O | Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin. |
| PROGRAMN | I | Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin. |
| DONE | I/O | Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin. |
| CCLK | I/O | Configuration Clock for configuring an FPGA in sysCONFIG mode. |
| BUSY/SISPI | I/O | Read control command in SPI or SPIm mode. |
| CSN | I | sysCONFIG chip select (active low). During configuration, a pull-up is enabled. |
| CS1N | I | sysCONFIG chip select (active low). During configuration, a pull-up is enabled. |
| WRITEN | I | Write Data on Parallel port (active low). |
| D[0]/SPIFASTN | I/O | sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPIm. When using the SPI or SPIm mode, this pin should either be tied high or low, must not be left floating. |
| D[1:6] | I/O | sysCONFIG Port Data I/O for Parallel |
| D[7]/SPID0 | I/O | sysCONFIG Port Data I/O for Parallel, SPI, SPIm |
| DOUT/CSO | O | Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port. |
| DI/CSSPI0N | I/O | Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIm modes. |
| Dedicated SERDES Signals^{1, 2, 3} | | |
| [LOC]_SQ_VCCAUX33 | — | Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused. |
| [LOC]_SQ_REFCLKN | I | Negative Reference Clock Input |
| [LOC]_SQ_REFCLKP | I | Positive Reference Clock Input |
| [LOC]_SQ_VCCP | — | PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused. |

Signal Descriptions (Cont.)

| Signal Name | I/O | Description |
|-------------------------------|-----|---|
| [LOC]_SQ_VCCIBm | — | Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused. |
| [LOC]_SQ_VCCOBm | — | Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused. |
| [LOC]_SQ_HDOUINm | O | High-speed output, negative channel m |
| [LOC]_SQ_HDOUOPm | O | High-speed output, positive channel m |
| [LOC]_SQ_HDINNm | I | High-speed input, negative channel m |
| [LOC]_SQ_HDINPm | I | High-speed input, positive channel m |
| [LOC]_SQ_VCCTXm ⁴ | — | Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused. |
| [LOC]_SQ_VCCR Xm ⁴ | — | Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused. |

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLs that do not have dedicated I/Os.

PICs and DDR Data (DQ) Pins Associated with the DDR Strobe (DQS) Pin

| PICs Associated with DQS Strobe | PIO Within PIC | DDR Strobe (DQS) and Data (DQ) Pins |
|---|----------------|-------------------------------------|
| For Left and Right Edges of the Device | | |
| P[Edge] [n-4] | A | DQ |
| | B | DQ |
| P[Edge] [n-3] | A | DQ |
| | B | DQ |
| P[Edge] [n-2] | A | DQ |
| | B | DQ |
| P[Edge] [n-1] | A | DQ |
| | B | DQ |
| P[Edge] [n] | A | [Edge]DQSn |
| | B | DQ |
| P[Edge] [n+1] | A | DQ |
| | B | DQ |
| P[Edge] [n+2] | A | DQ |
| | B | DQ |
| P[Edge] [n+3] | A | DQ |
| | B | DQ |
| For Bottom Edge of the Device | | |
| P[Edge] [n-4] | A | DQ |
| | B | DQ |
| P[Edge] [n-3] | A | DQ |
| | B | DQ |
| P[Edge] [n-2] | A | DQ |
| | B | DQ |
| P[Edge] [n-1] | A | DQ |
| | B | DQ |
| P[Edge] [n] | A | [Edge]DQSn |
| | B | DQ |
| P[Edge] [n+1] | A | DQ |
| | B | DQ |
| P[Edge] [n+2] | A | DQ |
| | B | DQ |
| P[Edge] [n+3] | A | DQ |
| | B | DQ |
| P[Edge] [n+4] | A | DQ |
| | B | DQ |

Notes:

1. "n" is a row PIC number.
2. The DDR interface is designed for memories that support one DQS strobe up to 15 bits of data for the left and right edges and up to 17 bits of data for the bottom edge. In some packages, all the potential DDR data (DQ) pins may not be available. PIC numbering definitions are provided in the "Signal Names" column of the Signal Descriptions table.

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12

| Pin Type | | LFE2-6 | | LFE2-12 | | | |
|---|--------------------------|----------|-----------|----------|----------|-----------|-----------|
| | | 144 TQFP | 256 fpBGA | 144 TQFP | 208 PQFP | 256 fpBGA | 484 fpBGA |
| Single Ended User I/O | | 90 | 190 | 93 | 131 | 193 | 297 |
| Differential Pair User I/O | | 43 | 95 | 45 | 62 | 96 | 148 |
| Configuration | TAP Pins | 5 | 5 | 5 | 5 | 5 | 5 |
| | Muxed Pins | 14 | 14 | 14 | 14 | 14 | 14 |
| | Dedicated Pins (Non TAP) | 7 | 7 | 7 | 7 | 7 | 7 |
| Non Configuration | Muxed Pins | 34 | 54 | 33 | 40 | 54 | 57 |
| | Dedicated Pins | 3 | 3 | 3 | 3 | 3 | 3 |
| VCC | | 10 | 7 | 10 | 14 | 7 | 16 |
| VCCAUX | | 4 | 4 | 4 | 8 | 4 | 16 |
| VCCPLL | | 0 | 0 | 0 | 0 | 0 | 0 |
| VCCIO | Bank0 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank1 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank2 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank3 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank4 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank5 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank6 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank7 | 1 | 2 | 1 | 2 | 2 | 4 |
| | Bank8 | 1 | 1 | 1 | 2 | 1 | 2 |
| GND, GND0 to GND7 | | 12 | 20 | 12 | 22 | 20 | 60 |
| NC | | 4 | 3 | 1 | 0 | 0 | 44 |
| Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors) | Bank0 | 8/4 | 18/6 | 8/4 | 18/9 | 18/9 | 50/25 |
| | Bank1 | 17/8 | 34/17 | 18/9 | 18/9 | 34/17 | 46/23 |
| | Bank2 | 4/2 | 20/10 | 4/2 | 11/5 | 20/10 | 24/12 |
| | Bank3 | 8/4 | 12/6 | 8/4 | 11/5 | 12/6 | 16/8 |
| | Bank4 | 18/9 | 32/16 | 18/9 | 19/9 | 32/16 | 46/23 |
| | Bank5 | 8/4 | 14/7 | 10/5 | 18/9 | 17/8 | 46/23 |
| | Bank6 | 9/4 | 26/13 | 9/4 | 18/8 | 26/13 | 32/16 |
| | Bank7 | 12/6 | 20/10 | 12/6 | 12/6 | 20/10 | 23/11 |
| | Bank8 | 6/2 | 14/7 | 6/2 | 6/2 | 14/7 | 14/7 |
| True LVDS I/O Pairs per Bank | Bank0 (Top Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 (Top Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 (Right Edge) | 1 | 5 | 1 | 4 | 5 | 6 |
| | Bank3 (Right Edge) | 3 | 3 | 3 | 3 | 3 | 4 |
| | Bank4 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank5 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank6 (Left Edge) | 2 | 7 | 2 | 6 | 7 | 8 |
| | Bank7 (Left Edge) | 5 | 5 | 5 | 5 | 5 | 5 |
| | Bank8 (Right Edge) | 0 | 0 | 0 | 0 | 0 | 0 |

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12 (Cont.)

| Pin Type | | LFE2-6 | | LFE2-12 | | | |
|--|-------|----------|-----------|----------|----------|-----------|-----------|
| | | 144 TQFP | 256 fpBGA | 144 TQFP | 208 PQFP | 256 fpBGA | 484 fpBGA |
| Available DDR-Interfaces per I/O Bank ¹ | Bank0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 1 | 0 | 0 | 1 | 1 |
| | Bank3 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank4 | 0 | 2 | 0 | 0 | 2 | 3 |
| | Bank5 | 0 | 1 | 0 | 0 | 1 | 3 |
| | Bank6 | 0 | 1 | 0 | 0 | 1 | 1 |
| | Bank7 | 0 | 1 | 0 | 0 | 1 | 1 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 | 0 |
| PCI Capable I/Os per Bank | Bank0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank3 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank4 | 18 | 32 | 18 | 19 | 32 | 46 |
| | Bank5 | 8 | 14 | 10 | 18 | 17 | 46 |
| | Bank6 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank7 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 | 0 |

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

| Pin Type | | LFE2-20 | | | | LFE2-35 | |
|---|--------------------------|-------------|--------------|--------------|--------------|--------------|--------------|
| | | 208 PQFP | 256 fpBGA | 484 fpBGA | 672 fpBGA | 484 fpBGA | 672 fpBGA |
| Single Ended User I/O | | 131 | 193 | 331 | 402 | 331 | 450 |
| Differential Pair User I/O | | 62 | 96 | 165 | 200 | 165 | 224 |
| Configuration | TAP Pins | 5 | 5 | 5 | 5 | 5 | 5 |
| | Muxed Pins | 14 | 14 | 14 | 14 | 14 | 14 |
| | Dedicated Pins (Non TAP) | 7 | 7 | 7 | 7 | 7 | 7 |
| Non Configuration | Muxed Pins | 42 | 54 | 60 | 64 | 60 | 68 |
| | Dedicated Pins | 3 | 3 | 3 | 3 | 3 | 3 |
| VCC | | 14 | 7 | 18 | 24 | 16 | 22 |
| VCCAUX | | 8 | 4 | 16 | 16 | 16 | 16 |
| VCCPLL | | 0 | 0 | 0 | 0 | 2 | 2 |
| VCCIO | Bank0 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank1 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank2 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank3 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank4 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank5 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank6 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank7 | 2 | 2 | 4 | 5 | 4 | 5 |
| | Bank8 | 2 | 1 | 2 | 2 | 2 | 2 |
| GND, GND0 to GND7 | | 22 | 20 | 60 | 72 | 60 | 72 |
| NC | | 0 | 1 | 8 | 101 | 8 | 102 |
| Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors) | Bank0 | 18/9 | 18/9 | 50/25 | 67/33 | 50/25 | 67/33 |
| | Bank1 | 18/9 | 34/17 | 46/23 | 52/26 | 46/23 | 52/26 |
| | Bank2 | 11/5 | 20/10 | 34/17 | 36/18 | 34/17 | 48/24 |
| | Bank3 | 11/5 | 12/6 | 22/11 | 32/16 | 22/11 | 42/21 |
| | Bank4 | 19/9 | 32/16 | 46/23 | 50/25 | 46/23 | 54/27 |
| | Bank5 | 18/9 | 17/8 | 46/23 | 68/34 | 46/23 | 68/34 |
| | Bank6 | 18/8 | 26/13 | 40/20 | 48/24 | 40/20 | 58/29 |
| | Bank7 | 12/6 | 20/10 | 33/16 | 35/17 | 33/16 | 47/23 |
| | Bank8 | 6/2 | 14/7 | 14/7 | 14/7 | 14/7 | 14/7 |
| True LVDS I/O Pairs per Bank | Bank0 (Top Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 (Top Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 (Right Edge) | 4 | 5 | 9 | 9 | 9 | 12 |
| | Bank3 (Right Edge) | 3 | 3 | 5 | 8 | 5 | 9 |
| | Bank4 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank5 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank6 (Left Edge) | 6 | 7 | 10 | 12 | 10 | 13 |
| | Bank7 (Left Edge) | 5 | 5 | 8 | 8 | 8 | 11 |
| | Bank8 (Right Edge) | 0 | 0 | 0 | 0 | 0 | 0 |

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35 (Cont.)

| Pin Type | | LFE2-20 | | | | LFE2-35 | |
|--|-------|-------------|--------------|--------------|--------------|--------------|--------------|
| | | 208 PQFP | 256 fpBGA | 484 fpBGA | 672 fpBGA | 484 fpBGA | 672 fpBGA |
| Available DDR-Interfaces per I/O Bank ¹ | Bank0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 1 | 2 | 2 | 2 | 3 |
| | Bank3 | 0 | 0 | 0 | 2 | 0 | 2 |
| | Bank4 | 0 | 2 | 3 | 3 | 3 | 3 |
| | Bank5 | 0 | 1 | 3 | 4 | 3 | 4 |
| | Bank6 | 0 | 1 | 2 | 3 | 1 | 3 |
| | Bank7 | 0 | 1 | 2 | 2 | 2 | 3 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 | 0 |
| PCI Capable I/Os per Bank | Bank0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank3 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank4 | 19 | 32 | 46 | 50 | 46 | 54 |
| | Bank5 | 18 | 17 | 46 | 68 | 46 | 68 |
| | Bank6 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank7 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 | 0 |

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70

| Pin Type | | LFE2-50 | | LFE2-70 | |
|---|--------------------------|-----------|-----------|-----------|-----------|
| | | 484 fpBGA | 672 fpBGA | 672 fpBGA | 900 fpBGA |
| Single Ended User I/O | | 339 | 500 | 500 | 583 |
| Differential Pair User I/O | | 169 | 249 | 249 | 290 |
| Configuration | TAP Pins | 5 | 5 | 5 | 5 |
| | Muxed Pins | 14 | 14 | 14 | 14 |
| | Dedicated Pins (Non TAP) | 7 | 7 | 7 | 7 |
| Non Configuration | Muxed Pins | 68 | 79 | 79 | 89 |
| | Dedicated Pins | 3 | 3 | 3 | 3 |
| VCC | | 16 | 20 | 20 | 26 |
| VCCAUX | | 16 | 16 | 16 | 17 |
| VCCPLL | | 4 | 4 | 2 | 4 |
| VCCIO | Bank0 | 4 | 5 | 5 | 6 |
| | Bank1 | 4 | 5 | 5 | 6 |
| | Bank2 | 4 | 5 | 5 | 6 |
| | Bank3 | 4 | 5 | 5 | 6 |
| | Bank4 | 4 | 5 | 5 | 6 |
| | Bank5 | 4 | 5 | 5 | 6 |
| | Bank6 | 4 | 5 | 5 | 6 |
| | Bank7 | 4 | 5 | 5 | 6 |
| | Bank8 | 2 | 2 | 2 | 2 |
| GND, GND0 to GND7 | | 60 | 72 | 72 | 104 |
| NC | | 0 | 3 | 5 | 101 |
| Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors) | Bank0 | 50/25 | 67/33 | 67/33 | 84/42 |
| | Bank1 | 46/23 | 66/33 | 66/33 | 76/38 |
| | Bank2 | 38/19 | 56/28 | 56/28 | 74/37 |
| | Bank3 | 22/11 | 48/24 | 48/24 | 48/24 |
| | Bank4 | 46/23 | 62/31 | 62/31 | 72/35 |
| | Bank5 | 46/23 | 68/34 | 68/34 | 80/40 |
| | Bank6 | 40/20 | 64/32 | 64/32 | 64/32 |
| | Bank7 | 37/18 | 55/27 | 55/27 | 71/35 |
| | Bank8 | 14/7 | 14/7 | 14/7 | 14/7 |
| True LVDS I/O Pairs per Bank | Bank0 (Top Edge) | 0 | 0 | 0 | 0 |
| | Bank1 (Top Edge) | 0 | 0 | 0 | 0 |
| | Bank2 (Right Edge) | 9 | 13 | 13 | 18 |
| | Bank3 (Right Edge) | 5 | 12 | 12 | 12 |
| | Bank4 (Bottom Edge) | 0 | 0 | 0 | 0 |
| | Bank5 (Bottom Edge) | 0 | 0 | 0 | 0 |
| | Bank6 (Left Edge) | 10 | 16 | 16 | 16 |
| | Bank7 (Left Edge) | 8 | 12 | 12 | 16 |
| | Bank8 (Right Edge) | 0 | 0 | 0 | 0 |

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70 (Cont.)

| Pin Type | | LFE2-50 | | LFE2-70 | |
|--|-------|-----------|-----------|-----------|-----------|
| | | 484 fpBGA | 672 fpBGA | 672 fpBGA | 900 fpBGA |
| Available DDR-Interfaces per I/O Bank ¹ | Bank0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 |
| | Bank2 | 2 | 3 | 3 | 4 |
| | Bank3 | 0 | 3 | 3 | 3 |
| | Bank4 | 3 | 4 | 4 | 4 |
| | Bank5 | 3 | 4 | 4 | 5 |
| | Bank6 | 1 | 4 | 4 | 4 |
| | Bank7 | 2 | 3 | 3 | 4 |
| | Bank8 | 0 | 0 | 0 | 0 |
| PCI Capable I/Os per Bank | Bank0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 0 | 0 | 0 |
| | Bank3 | 0 | 0 | 0 | 0 |
| | Bank4 | 46 | 62 | 62 | 72 |
| | Bank5 | 46 | 68 | 68 | 80 |
| | Bank6 | 0 | 0 | 0 | 0 |
| | Bank7 | 0 | 0 | 0 | 0 |
| | Bank8 | 0 | 0 | 0 | 0 |

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35

| Pin Type | | LFE2M20 | | LFE2M35 | | |
|---|--------------------------|-----------|-----------|-----------|-----------|-----------|
| | | 256 fpBGA | 484 fpBGA | 256 fpBGA | 484 fpBGA | 672 fpBGA |
| Single Ended User I/O | | 140 | 304 | 140 | 303 | 410 |
| Differential Pair User I/O | | 70 | 152 | 70 | 151 | 199 |
| Configuration | TAP Pins | 5 | 5 | 5 | 5 | 5 |
| | Muxed Pins | 14 | 14 | 14 | 14 | 14 |
| | Dedicated Pins (Non TAP) | 7 | 7 | 7 | 7 | 7 |
| Non Configuration | Muxed Pins | 64 | 84 | 60 | 84 | 89 |
| | Dedicated Pins | 3 | 3 | 3 | 3 | 3 |
| VCC | | 6 | 16 | 6 | 16 | 29 |
| VCCAUX | | 4 | 8 | 4 | 8 | 17 |
| VCCPLL | | 1 | 4 | 1 | 4 | 8 |
| VCCIO | Bank0 | 1 | 4 | 1 | 4 | 5 |
| | Bank1 | 1 | 3 | 1 | 3 | 4 |
| | Bank2 | 2 | 4 | 2 | 4 | 5 |
| | Bank3 | 2 | 4 | 2 | 4 | 5 |
| | Bank4 | 2 | 4 | 2 | 4 | 4 |
| | Bank5 | 2 | 4 | 2 | 4 | 5 |
| | Bank6 | 2 | 4 | 2 | 4 | 5 |
| | Bank7 | 2 | 4 | 2 | 4 | 5 |
| | Bank8 | 1 | 2 | 1 | 2 | 2 |
| GND, GND0 to GND7 | | 22 | 57 | 22 | 57 | 80 |
| NC | | 17 | 11 | 17 | 12 | 37 |
| Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors) | Bank0 | 0/0 | 36/18 | 0/0 | 36/18 | 63/31 |
| | Bank1 | 0/0 | 18/9 | 0/0 | 18/9 | 18/9 |
| | Bank2 | 14/7 | 30/15 | 14/7 | 30/15 | 50/25 |
| | Bank3 | 16/8 | 36/18 | 16/8 | 36/18 | 43/21 |
| | Bank4 | 32/16 | 62/31 | 32/16 | 62/31 | 50/21 |
| | Bank5 | 20/10 | 28/14 | 20/10 | 28/14 | 60/30 |
| | Bank6 | 16/8 | 40/20 | 16/8 | 39/19 | 52/25 |
| | Bank7 | 28/14 | 40/20 | 28/14 | 40/20 | 60/30 |
| | Bank8 | 14/7 | 14/7 | 14/7 | 14/7 | 14/7 |
| True LVDS I/O Pairs per Bank | Bank0 (Top Edge) | 0 | 0 | 0 | 0 | 0 |
| | Bank1 (Top Edge) | 0 | 0 | 0 | 0 | 0 |
| | Bank2 (Right Edge) | 3 | 7 | 3 | 7 | 12 |
| | Bank3 (Right Edge) | 4 | 9 | 4 | 9 | 11 |
| | Bank4 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 |
| | Bank5 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 |
| | Bank6 (Left Edge) | 4 | 10 | 4 | 10 | 14 |
| | Bank7 (Left Edge) | 7 | 10 | 7 | 10 | 15 |
| | Bank8 (Right Edge) | 0 | 0 | 0 | 0 | 0 |

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35 (Cont.)

| Pin Type | | LFE2M20 | | LFE2M35 | | |
|--|-------|-----------|-----------|-----------|-----------|-----------|
| | | 256 fpBGA | 484 fpBGA | 256 fpBGA | 484 fpBGA | 672 fpBGA |
| Available DDR-Interfaces per I/O Bank ¹ | Bank0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 1 | 0 | 1 | 3 |
| | Bank3 | 0 | 1 | 0 | 1 | 2 |
| | Bank4 | 2 | 4 | 2 | 4 | 3 |
| | Bank5 | 1 | 2 | 1 | 2 | 3 |
| | Bank6 | 0 | 3 | 0 | 1 | 2 |
| | Bank7 | 1 | 2 | 1 | 2 | 3 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 |
| PCI Capable I/Os per Bank | Bank0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 0 | 0 | 0 | 0 |
| | Bank3 | 0 | 0 | 0 | 0 | 0 |
| | Bank4 | 32 | 62 | 32 | 62 | 50 |
| | Bank5 | 20 | 28 | 20 | 28 | 60 |
| | Bank6 | 16 | 40 | 16 | 39 | 52 |
| | Bank7 | 28 | 40 | 28 | 40 | 60 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 |

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100

| Pin Type | | LFE2M50 | | | LFE2M70 | | LFE2M100 | |
|---|--------------------------|-----------|-----------|-----------|-----------|------------|-----------|------------|
| | | 484 fpBGA | 672 fpBGA | 900 fpBGA | 900 fpBGA | 1152 fpBGA | 900 fpBGA | 1152 fpBGA |
| Single Ended User I/O | | 270 | 372 | 410 | 416 | 436 | 416 | 520 |
| Differential Pair User I/O | | 135 | 185 | 205 | 208 | 218 | 207 | 260 |
| Configuration | TAP Pins | 5 | 5 | 5 | 5 | 5 | 5 | 5 |
| | Muxed Pins | 14 | 14 | 14 | 14 | 14 | 14 | 14 |
| | Dedicated Pins (Non TAP) | 7 | 7 | 7 | 7 | 7 | 7 | 7 |
| Non Configuration | Muxed Pins | 69 | 72 | 72 | 75 | 76 | 74 | 78 |
| | Dedicated Pins | 3 | 3 | 3 | 3 | 3 | 3 | 3 |
| VCC | | 16 | 20 | 62 | 44 | 44 | 44 | 44 |
| VCCAUX | | 8 | 26 | 18 | 16 | 12 | 16 | 12 |
| VCCPLL | | 4 | 8 | 4 | 4 | 4 | 4 | 4 |
| VCCIO | Bank0 | 4 | 5 | 6 | 6 | 7 | 6 | 7 |
| | Bank1 | 3 | 4 | 6 | 6 | 7 | 6 | 7 |
| | Bank2 | 4 | 5 | 9 | 9 | 9 | 9 | 9 |
| | Bank3 | 4 | 5 | 9 | 9 | 9 | 9 | 9 |
| | Bank4 | 4 | 4 | 6 | 6 | 7 | 6 | 7 |
| | Bank5 | 4 | 5 | 6 | 6 | 7 | 6 | 7 |
| | Bank6 | 4 | 5 | 9 | 9 | 9 | 9 | 9 |
| | Bank7 | 4 | 5 | 9 | 9 | 9 | 9 | 9 |
| | Bank8 | 2 | 2 | 2 | 2 | 2 | 2 | 2 |
| GND, GND0 to GND7 | | 57 | 80 | 122 | 122 | 134 | 122 | 134 |
| NC | | 31 | 35 | 121 | 63 | 283 | 63 | 199 |
| Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors) | Bank0 | 36/18 | 63/31 | 56/28 | 34/17 | 46/23 | 34/17 | 54/27 |
| | Bank1 | 18/9 | 18/9 | 36/18 | 42/21 | 34/17 | 42/21 | 44/22 |
| | Bank2 | 30/15 | 50/25 | 54/27 | 70/35 | 72/36 | 70/35 | 80/40 |
| | Bank3 | 36/18 | 43/21 | 44/22 | 60/30 | 64/32 | 60/30 | 80/40 |
| | Bank4 | 42/21 | 24/12 | 38/19 | 38/19 | 40/20 | 38/19 | 44/22 |
| | Bank5 | 28/14 | 60/30 | 58/29 | 40/20 | 40/20 | 40/20 | 46/23 |
| | Bank6 | 40/20 | 54/27 | 60/30 | 62/31 | 66/33 | 62/31 | 82/41 |
| | Bank7 | 40/20 | 60/30 | 64/32 | 70/35 | 74/37 | 70/35 | 90/45 |
| | Bank8 | 0/0 | 0/0 | 0/0 | 0/0 | 0/0 | 0/0 | 0/0 |
| True LVDS I/O Pairs per Bank | Bank0 (Top Edge) | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 (Top Edge) | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 (Right Edge) | 7 | 12 | 13 | 17 | 18 | 17 | 20 |
| | Bank3 (Right Edge) | 9 | 11 | 11 | 15 | 16 | 15 | 20 |
| | Bank4 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank5 (Bottom Edge) | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank6 (Left Edge) | 10 | 14 | 15 | 15 | 16 | 15 | 20 |
| | Bank7 (Left Edge) | 10 | 15 | 17 | 17 | 18 | 17 | 22 |
| | Bank8 (Right Edge) | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 (Cont.)

| Pin Type | | LFE2M50 | | | LFE2M70 | | LFE2M100 | |
|--|-------|-----------|-----------|-----------|-----------|------------|-----------|------------|
| | | 484 fpBGA | 672 fpBGA | 900 fpBGA | 900 fpBGA | 1152 fpBGA | 900 fpBGA | 1152 fpBGA |
| Available DDR-Interfaces per I/O Bank ¹ | Bank0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 2 | 2 | 2 | 4 | 4 | 4 | 4 |
| | Bank3 | 2 | 1 | 1 | 3 | 4 | 3 | 5 |
| | Bank4 | 3 | 1 | 3 | 3 | 3 | 3 | 3 |
| | Bank5 | 2 | 3 | 3 | 2 | 3 | 2 | 3 |
| | Bank6 | 1 | 2 | 2 | 3 | 4 | 3 | 5 |
| | Bank7 | 3 | 3 | 3 | 4 | 4 | 4 | 5 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| PCI Capable I/Os per Bank | Bank0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Bank2 | 0 | 0 | 0 | 0 | 72 | 0 | 80 |
| | Bank3 | 0 | 0 | 0 | 0 | 64 | 0 | 80 |
| | Bank4 | 50 | 24 | 48 | 48 | 40 | 48 | 44 |
| | Bank5 | 60 | 60 | 50 | 40 | 40 | 40 | 46 |
| | Bank6 | 52 | 54 | 60 | 62 | 66 | 62 | 82 |
| | Bank7 | 60 | 60 | 68 | 70 | 74 | 70 | 90 |
| | Bank8 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

Available Device Resources by Package, LatticeECP2

| Resource | Device | 256 fpBGA | 484 fpBGA | 672 fpBGA | 900 fpBGA |
|----------|---------|-----------|-----------|-----------|-----------|
| PLL/DLL | ECP2-6 | 4 | — | — | — |
| | ECP2-12 | 4 | 4 | — | — |
| | ECP2-20 | 4 | 4 | 4 | — |
| | ECP2-35 | — | 4 | 4 | — |
| | ECP2-50 | — | 6 | 6 | — |
| | ECP2-70 | — | — | 8 | 8 |

Available Device Resources by Package, LatticeECP2M

| Resource | Device | 256 fpBGA | 484 fpBGA | 672 fpBGA | 900 fpBGA | 1152 fpBGA |
|----------|----------|-----------|-----------|-----------|-----------|------------|
| PLL/DLL | ECP2M20 | 10 | 10 | — | — | — |
| | ECP2M35 | 10 | 10 | 10 | — | — |
| | ECP2M50 | — | 10 | 10 | 10 | — |
| | ECP2M70 | — | — | — | 10 | 10 |
| | ECP2M100 | — | — | — | 10 | 10 |

LatticeECP2 Power Supply and NC

| Signals | 144 TQFP ³ | 208 PQFP ³ | 256 fpBGA ⁴ | 484 fpBGA ⁴ |
|------------------|--|--|---|--|
| VCC | 16, 22, 29, 48, 54, 83, 94, 102, 128, 135 | 12, 19, 28, 40, 74, 80, 97, 116, 129, 140, 146, 171, 188, 198 | LFE2-6: G7, G9, G10, H7, J10, K10, K8 LFE2-12/LFE2-20: G7, G9, G10, H7, J10, K10, K8 | LFE2-12/LFE2-20: N6, N18, J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 LFE2-35/LFE2-50: J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 |
| VCCIO0 | 139 | 195, 206 | C5, E7 | G10, G9, H8, H9 |
| VCCIO1 | 117 | 162, 170 | C12, E10 | G11, G12, G13, G14 |
| VCCIO2 | 106 | 143, 148 | E14, G12 | H14, H15, J15, K16 |
| VCCIO3 | 89 | 123, 135 | K12, M14 | L16, M16, N16, P16 |
| VCCIO4 | 64 | 93, 100 | M10, P12 | R14, T12, T13, T14 |
| VCCIO5 | 42 | 55, 63 | M7, P5 | R9, T10, T11, T9 |
| VCCIO6 | 31 | 38, 44 | K5, M3 | N7, P7, P8, R8 |
| VCCIO7 | 9 | 10, 14 | E3, G5 | J8, K7, L7, M7 |
| VCCIO8 | 85 | 113, 118 | T15 | P15, R15 |
| VCCJ | 35 | 51 | K7 | T8 |
| VCCAUX | 6, 39, 90, 142 | 7, 30, 70, 86, 125, 151, 174, 190 | G8, H10, J7, K9 | G5, K5, R5, V7, V11, V8, V13, V15, M17, P17, E17, G18, D11, F13, C5, E6 |
| VCCPLL | None | None | None | LFE2-12/LFE2-20: None LFE2-35: N6, N18 LFE2-50: N6, N18, K6, J16 |
| GND ¹ | 11, 21, 30, 47, 51, 61, 81, 95, 105, 120, 133, 138 | 5, 13, 17, 25, 32, 42, 60, 68, 77, 81, 89, 102, 115, 122, 139, 145, 159, 169, 175, 184, 192, 201 | A1, A16, B12, B5, C8, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16 | A22, AA19, AA4, AB1, AB22, B19, B4, C14, C9, D2, D21, F17, F6, H10, H11, H12, H13, J14, J20, J3, J9, K10, K11, K12, K13, K15, K8, L10, L11, L12, L13, L15, L8, M10, M11, M12, M13, M15, M8, N10, N11, N12, N13, N15, N8, P14, P20, P3, P9, R10, R11, R12, R13, U17, U6, W2, W21, Y14, Y9, A1 |
| NC ² | LFE2-6: 45, 46, 124, 127 LFE2-12: 127 | None | LFE2-6: K6, R3, P4 LFE2-12/LFE2-20: None | LFE2-12: E3, F3, F1, H4, F2, H5, G1, G3, G2, G4, K6, N1, M2, N2, M1, N3, N5, N4, P5, N19, M19, J22, L22, H22, K22, J16, D22, F21, E21, E22, H19, G20, G19, F20, C21, C22, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-20/LFE2-35: K6, J16, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-50: None |

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. Pin orientation follows the conventional order from the pin 1 marking of the top side view and counter-clockwise.
4. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LatticeECP2 Power Supply and NC (Cont.)

| Signals | 672 fpBGA ³ | 900 fpBGA ³ |
|------------------|---|--|
| VCC | LFE2-20: R8, P18, M8, L20, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-35/LFE2-50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-70: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 | AA11, AA20, K11, K21, K22, L11, L12, L13, L18, L19, L20, M11, M20, N11, N20, V11, V20, W11, W20, Y10, Y11, Y12, Y13, Y18, Y19, Y20 |
| VCCIO0 | D11, D6, G9, J12, K12 | J13, J14, K12, K13, K14, K15 |
| VCCIO1 | D16, D21, G18, J15, K15 | J17, J18, J20, K17, K18, K20 |
| VCCIO2 | F23, J20, L23, M17, M18 | L21, M21, M22, N21, N22, R21 |
| VCCIO3 | AA23, R17, R18, T23, V20 | U21, U22, V21, V22, W21, Y22 |
| VCCIO4 | AC16, AC21, U15, V15, Y18 | AA16, AA17, AA18, AA19, AB17, AB18 |
| VCCIO5 | AC11, AC6, U12, V12, Y9 | AA12, AA13, AA14, AB12, AB13, AB14 |
| VCCIO6 | AA4, R10, R9, T4, V7 | U10, U9, V10, W10, W9, Y9 |
| VCCIO7 | F4, J7, L4, M10, M9 | L10, L9, M10, N10, P10, R10 |
| VCCIO8 | AE25, V18 | AA21, Y21 |
| VCCJ | AB5 | AD3 |
| VCCAUX | J10, J11, J16, J17, K18, L18, T18, U18, V16, V17, V10, V11, T9, U9, K9, L9 | AA15, AB11, AB19, AB20, J11, J12, J19, K19, L22, M9, N9, P21, P9, T10, T21, V9, W22 |
| VCCPLL | LFE2-20: None LFE2-35/LFE2-70: R8, P18 LFE2-50: R8, P18, M8, L20 | P22, P8, T22, Y7 |
| GND ¹ | A2, A25, AA18, AA24, AA3, AA9, AD11, AD16, AD21, AD6, AE1, AE26, AF2, AF25, B1, B26, C11, C16, C21, C6, F18, F24, F3, F9, J13, J14, J21, J6, K10, K11, K13, K14, K16, K17, L10, L11, L16, L17, L24, L3, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T24, T3, U10, U11, U13, U14, U16, U17, V13, V14, V21, V6 | A1, A30, AC28, AC3, AH13, AH18, AH23, AH28, AH3, AH8, AK1, AK30, C13, C18, C23, C28, C3, C8, H28, H3, L14, L15, L16, L17, M12, M13, M14, M15, M16, M17, M18, M19, N12, N13, N14, N15, N16, N17, N18, N19, N28, N3, P11, P12, P13, P14, P15, P16, P17, P18, P19, P20, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, T11, T12, T13, T14, T15, T16, T17, T18, T19, T20, U11, U12, U13, U14, U15, U16, U17, U18, U19, U20, V12, V13, V14, V15, V16, V17, V18, V19, V28, V3, W12, W13, W14, W15, W16, W17, W18, W19, Y14, Y15, Y16, Y17 |
| NC ² | LFE2-20: E4, E3, E2, E1, H6, H5, F2, F1, H8, J9, G4, G3, K3, K2, K1, L2, L1, M2, M1, N2, T1, T2, P8, P6, P5, P4, U1, V1, P3, R3, R4, U2, V2, W2, T6, R5, AA19, W17, Y19, Y17, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, R22, T21, P26, P25, R24, R23, P20, R19, P21, P19, P23, P22, N22, R21, N26, N25, J26, J25, J23, K23, H26, H25, H24, H23, F22, E24, D25, C25, D24, B25, H21, G22, B24, C24, D23, C23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-35: K3, K2, K1, L2, L1, M2, M1, N2, M8, P3, R3, R4, U2, V2, W2, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, P26, P25, R24, R23, P20, R19, L20, J26, J25, J23, K23, H26, H25, H24, H23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-50: N6, P24, M3 LFE2-70: M8, L20, M3, P24, N6 | A2, A3, A4, A5, AB28, AC4, AD23, AE1, AE2, AE29, AE3, AE30, AE4, AE5, AE6, AF1, AF2, AF23, AF26, AF27, AF28, AF29, AF3, AF30, AF4, AF5, AG1, AG13, AG16, AG18, AG2, AG26, AG27, AG28, AG29, AG3, AG30, AG4, AG8, AH1, AH16, AH2, AH26, AH27, AH29, AH30, AH4, AJ1, AJ2, AJ27, AJ28, AJ29, AJ3, AJ30, AK2, AK27, AK28, AK29, AK3, B1, B2, B3, B30, B4, B5, C1, C2, C29, C30, C4, D13, D18, D23, D28, D29, D3, D30, D4, E25, E26, E27, E28, E29, E3, E30, E4, E5, E6, F25, F5, F6, G6, G7, K10, K9, N27, N4, R1, R2, V27, V4 |

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.

2. NC pins should not be connected to any active signals, VCC or GND.

3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LatticeECP2M Power Supply and NC

| Signal | 256 fpBGA | 484 fpBGA |
|---------------------------|--|---|
| V _{CC} | G7, G9, H7, J10, K10, K8 | J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 |
| V _{CCIO0} | E7 | B5, B9, E7, H9 |
| V _{CCIO1} | E10 | D13, E16, H14 |
| V _{CCIO2} | E14, G12 | E21, G18, J15, K19 |
| V _{CCIO3} | K12, M14 | N19, P15, T18, V21 |
| V _{CCIO4} | M10, P12 | AA18, R14, V16, W13 |
| V _{CCIO5} | M7, P5 | AA5, R9, V7, W10 |
| V _{CCIO6} | K5, M3 | N4, P8, T5, V2 |
| V _{CCIO7} | E3, G5 | E2, G5, J8, K4 |
| V _{CCIO8} | T15 | AA22, U19 |
| V _{CCJ} | K7 | W4 |
| V _{CCAUX} | G8, H10, J7, K9 | H11, H12, L15, L8, M15, M8, R11, R12 |
| V _{CCPLL} | G10 | R8, H15, H8, R15 |
| SERDES Power ³ | C15, B15, C12, A12, C11, C10, C14, C13, B9, C9, C5, C4, C8, C7, A6, C6, B3, C3 | C22, B22, C19, A19, C18, C17, C21, C20, B16, C16, C12, C11, C15, C14, A13, C13, B10, C10 |
| GND ¹ | A1, A15, A16, A3, A9, B12, B6, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16 | A1, A10, A16, A22, AA19, AA4, AB1, AB22, B13, B19, B4, D16, D2, D21, D7, G19, G4, H10, H13, J14, J9, K10, K11, K12, K13, K15, K20, K3, K8, L10, L11, L12, L13, M10, M11, M12, M13, N10, N11, N12, N13, N15, N20, N3, N8, P14, P9, R10, R13, T19, T4, W16, W2, W21, W7, Y10, Y13 |
| NC ² | D10, D11, D12, D13, D14, D4, D5, D6, D7, E11, E6, E8, E9, F10, F7, F8, F9 | LFE2M20: D14, D15, E14, E15, F13, F14, F15, G12, G13, G14, G15 LFE2M35: D14, D15, E14, E15, F13, F14, F15, G12, G13, G14, G15, U6 LFE2M50: Y15, W15, AB20, AB21, AA20, AB19, AB18, Y22, Y21, Y17, Y18, Y16, W17, Y19, Y20, W19, W18, V17, V18, D15, G14, G15, D14, E15, E14, F15, F14, F13, G12, G13 |

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LatticeECP2M Power Supply and NC (Cont.)

| Signal | 672 fpBGA | 900 fpBGA |
|---------------------------|---|--|
| V _{CC} | <p>LFE2M35: AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15</p> <p>LFE2M50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15</p> | <p>LFE2M50: AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19</p> <p>LFE2M70/LFE2M100: L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19</p> |
| V _{CCIO0} | B12, B7, F11, J13, K12 | D14, E6, E9, F12, K12, K13 |
| V _{CCIO1} | D18, F16, J14, K15 | D17, E22, E25, F19, K18, K19 |
| V _{CCIO2} | G25, L21, M17, M25, N18 | F28, J25, K28, M21, M24, N21, N28, P21, R25 |
| V _{CCIO3} | P18, R17, R25, T21, Y25 | AA28, AB25, AE28, T25, U21, V21, V28, W21, W24 |
| V _{CCIO4} | AA16, AC18, U15, V14 | AA18, AA19, AE19, AF22, AG17, AG25 |
| V _{CCIO5} | AA11, AE12, AE7, U12, V13 | AA12, AA13, AE12, AF9, AG14, AG6 |
| V _{CCIO6} | P9, R10, R2, T6, Y2 | AA3, AB6, AE3, T6, U10, V10, V3, W10, W7 |
| V _{CCIO7} | G2, L6, M10, M2, N9 | F3, J6, K3, M10, M7, N10, N3, P10, R6 |
| V _{CCIO8} | AC24, U17 | AA25, AD28 |
| V _{CCJ} | AA7 | AG1 |
| V _{CCAUX} | <p>LFE2M35: AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16</p> <p>LFE2M50: J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16</p> | <p>LFE2M50: AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21</p> <p>LFE2M70/LFE2M100: AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21</p> |
| V _{CCPLL} | H7, K6, P7, R8, V18, P20, J17, G19 | N13, N18, V13, V18 |
| SERDES Power ³ | <p>LFE2M35: C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13</p> <p>LFE2M50: AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13</p> | <p>LFE2M50: AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18</p> <p>LFE2M70/LFE2M100: C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13</p> |

LatticeECP2M Power Supply and NC (Cont.)

| Signal | 672 fpBGA | 900 fpBGA |
|------------------|--|--|
| GND ¹ | A13, A19, A2, A25, AA2, AA25, AB18, AB22, AB5, AB9, AE1, AE11, AE16, AE22, AE26, AE6, AF13, AF19, AF2, AF25, B1, B11, B16, B22, B26, B6, E18, E22, E5, E9, F2, F25, G11, G16, J22, J5, K11, K13, K14, K16, L10, L11, L16, L17, L2, L20, L25, L7, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T2, T20, T25, T7, U11, U13, U14, U16, V22, V5, Y11, Y16 | <p>LFE2M50: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17</p> <p>LFE2M70/LFE2M100: A1, A13, A18, A24, A30, A7, AA14, AA15, AA16, AA17, AA24, AA27, AA4, AB24, AB7, AD12, AD19, AD27, AE22, AE27, AE4, AE9, AF14, AF17, AF25, AF6, AJ10, AJ21, AJ27, AJ4, AK1, AK13, AK18, AK24, AK30, AK7, B10, B21, B27, B4, D25, D6, E14, E17, F22, F27, F4, F9, G12, G19, J24, J7, K14, K15, K16, K17, K27, K4, L14, L15, L16, L17, M23, M8, N14, N15, N16, N17, N27, N4, P11, P13, P14, P15, P16, P17, P18, P20, R10, R11, R13, R14, R15, R16, R17, R18, R20, R21, R24, R7, T10, T11, T13, T14, T15, T16, T17, T18, T20, T21, T24, T7, U11, U13, U14, U15, U16, U17, U18, U20, V14, V15, V16, V17, V27, V4, W23, W8, Y14, Y15, Y16, Y17</p> |
| NC ² | <p>LFE2M35: AB3, AB4, AC1, AC2, AD15, AD18, AD20, AD23, AE13, AE25, AF16, AF22, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, N7, V7</p> <p>LFE2M50: AB3, AB4, AC1, AC2, B4, B5, C26, D20, D21, D22, D23, D24, D25, D26, E20, E21, E25, E26, F20, G20, K10, K17, R4, U10, U23, V10, W7, AB21, AC20, AC21, AC22, AC23, AC25, AD26, W20</p> | <p>LFE2M50: G5, G4, K7, K8, E1, F2, F1, G3, G2, G1, L9, L7, K6, K5, L8, L6, AA1, AA2, Y3, AB1, Y9, Y8, Y7, AA7, AB2, AB3, AA5, AA6, AB4, AB5, AA8, AA9, AJ1, AK4, AH6, AH3, AH11, AH8, AK10, AJ13, AB26, AB27, Y24, Y25, AA29, Y28, Y30, Y29, W22, V22, Y27, Y26, W30, W29, W25, W26, L24, L23, D30, D29, K24, K25, J27, K26, J26, H26, H27, G26, H23, H24, D28, E28, J18, J19, H17, J17, F18, F17, B13, A10, C8, C11, C3, C6, A4, B1, AA26, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AC11, AC21, AC22, AD21, AD22, AE23, AF20, AF23, AG23, AG26, F20, F23, G10, G20, G21, H19, H20, H21, H22, J20, J21, R9, U22, W9</p> <p>LFE2M70/LFE2M100: AA26, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB19, AB20, AB21, AB9, AC10, AC11, AC21, AC22, AC8, AC9, AD21, AD22, AD4, AD5, AD6, AD7, AD8, AE23, AE5, AE6, AE7, AF20, AF23, AF5, AG23, AG26, D10, E10, E11, F10, F20, F23, F8, G10, G20, G21, G7, G8, G9, H19, H20, H21, H22, H6, H8, H9, J10, J20, J21, J9, K9, R9, U22, W9</p> |

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LatticeECP2M Power Supply and NC (Cont.)

| Signal | 1152 fpBGA |
|---------------------------|--|
| V _{CC} | AA13, AA14, AA15, AA16, AA17, AA18, AA19, AA20, AA21, AA22, AB14, AB15, AB20, AB21, N14, N15, N20, N21, P13, P14, P15, P16, P17, P18, P19, P20, P21, P22, R13, R14, R21, R22, T14, T21, U14, U21, V14, V21, W14, W21, Y13, Y14, Y21, Y22 |
| V _{CCI00} | C12, C16, E14, H12, H16, M14, M15 |
| V _{CCI01} | C19, C23, E21, H19, H23, M20, M21 |
| V _{CCI02} | G32, K28, K32, N27, N32, P23, R23, T27, T32 |
| V _{CCI03} | AA23, AB27, AB32, AE28, AE32, AH32, W27, W32, Y23 |
| V _{CCI04} | AC20, AC21, AG19, AG23, AK21, AM19, AM23 |
| V _{CCI05} | AC14, AC15, AG12, AG16, AK14, AM12, AM16 |
| V _{CCI06} | AA12, AB3, AB8, AE3, AE7, AH3, W3, W8, Y12 |
| V _{CCI07} | G3, K3, K7, N3, N8, P12, R12, T3, T8 |
| V _{CCI08} | AD28, AG32 |
| V _{CCJ} | AK3 |
| V _{CCAUX} | AB12, AB13, AB22, AB23, AC13, AC22, M13, M22, N12, N13, N22, N23 |
| V _{CCPLL} | R15, R20, Y15, Y20 |
| SERDES Power ³ | D7, B9, B8, D9, B7, E7, B6, D8, E6, D6, D4, B5, D3, B4, C1, B3, B1, B2, B33, B34, B32, C34, B31, D32, B30, D31, E29, D29, D27, B29, E28, B28, D26, B27, B26, D28, AL28, AN26, AN27, AL26, AN28, AK28, AN29, AL27, AL29, AK29, AL31, AN30, AL32, AN31, AM34, AN32, AN34, AN33, AN2, AN1, AN3, AM1, AN4, AL3, AN5, AL4, AL6, AK6, AL8, AN6, AK7, AN7, AL9, AN8, AN9, AL7 |
| GND ¹ | A1, A10, A13, A22, A25, A34, AB16, AB17, AB18, AB19, AB26, AB31, AB4, AB9, AC16, AC17, AC18, AC19, AD27, AE27, AE31, AE4, AE8, AF12, AF16, AF19, AF23, AG31, AH31, AH4, AJ14, AJ21, AK27, AK8, AL10, AL16, AL19, AL2, AL25, AL33, AP1, AP10, AP13, AP22, AP25, AP34, D10, D16, D19, D2, D25, D33, E27, E8, F14, F21, G31, G4, J12, J16, J19, J23, K27, K31, K4, K8, M16, M17, M18, M19, N16, N17, N18, N19, N26, N31, N4, N9, R16, R17, R18, R19, T12, T13, T15, T16, T17, T18, T19, T20, T22, T23, T26, T31, T4, T9, U12, U13, U15, U16, U17, U18, U19, U20, U22, U23, V12, V13, V15, V16, V17, V18, V19, V20, V22, V23, W12, W13, W15, W16, W17, W18, W19, W20, W22, W23, W26, W31, W4, W9, Y16, Y17, Y18, Y19 |
| NC ² | LFE2M70: H2, H1, G5, G6, M9, M10, H3, H4, P3, P4, P9, M7, P1, P2, N7, P7, AC7, AC5, AC6, AD5, AD4, AD3, AD10, AD8, AD2, AD1, AD9, AC11, AD6, AD7, AE1, AE2, AJ12, AH12, AL13, AK13, AE14, AG13, AH22, AH21, AG22, AG21, AF33, AF34, AC27, AC28, AD29, AD30, AE33, AE34, AD32, AD31, AB25, AC25, AB28, AA26, AD33, AD34, P30, P29, P31, P32, R25, T24, N34, N33, F24, G23, J22, G22, H21, K21, L19, L20, L18, K19, J14, L15, H14, K14, F12, D11, F11, E11, A11, A12, A23, A24, AA11, AB11, AC26, AC30, AD11, AD12, AD13, AD14, AD15, AD19, AD21, AD22, AD23, AE10, AE11, AE12, AE13, AE19, AE21, AE22, AE23, AF11, AF21, AF22, AF24, AF8, AF9, AG10, AG11, AG24, AG25, AG26, AG3, AG7, AG8, AG9, AH10, AH11, AH13, AH24, AH25, AH26, AH27, AH5, AH6, AH7, AH8, AH9, AJ10, AJ11, AJ13, AJ24, AJ25, AJ26, AJ27, AJ3, AJ4, AJ5, AJ6, AJ7, AJ8, AJ9, AK10, AK11, AK12, AK24, AK25, AK26, AK4, AK9, AL11, AL12, AL34, AM10, AM11, AM13, AM25, AN10, AN11, AN12, AN13, AN24, AN25, AP11, AP12, AP24, B10, B11, B12, B13, B22, B23, B24, B25, C10, C11, C13, C22, C24, C25, D1, D15, D24, D34, E10, E24, E25, E26, E3, E31, E32, E33, E34, E4, E9, F10, F25, F26, F27, F28, F29, F30, F31, F32, F33, F34, F5, F6, F7, F8, F9, G10, G11, G24, G25, G26, G27, G28, G29, G30, G33, G34, G7, G8, G9, H10, H11, H24, H25, H26, H27, H28, H29, H8, H9, J10, J11, J24, J25, J26, J9, K10, K11, K12, K13, K23, K24, K25, K26, L11, L12, L13, L14, L21, L22, L23, L24, L25, L26, M11, M24, M25, M6, M8, M10, N11, P10, P25, P26, R9, T11, U11, W11, Y10, Y11 LFE2M100: A11, A12, A23, A24, AA11, AB11, AC26, AC30, AD11, AD12, AD13, AD14, AD15, AD19, AD21, AD22, AD23, AE10, AE11, AE12, AE13, AE19, AE21, AE22, AE23, AF11, AF21, AF22, AF24, AF8, AF9, AG10, AG11, AG24, AG25, AG26, AG3, AG7, AG8, AG9, AH10, AH11, AH13, AH24, AH25, AH26, AH27, AH5, AH6, AH7, AH8, AH9, AJ10, AJ11, AJ13, AJ24, AJ25, AJ26, AJ27, AJ3, AJ4, AJ5, AJ6, AJ7, AJ8, AJ9, AK10, AK11, AK12, AK24, AK25, AK26, AK4, AK9, AL11, AL12, AL34, AM10, AM11, AM13, AM25, AN10, AN11, AN12, AN13, AN24, AN25, AP11, AP12, AP24, B10, B11, B12, B13, B22, B23, B24, B25, C10, C11, C13, C22, C24, C25, D1, D15, D24, D34, E10, E24, E25, E26, E3, E31, E32, E33, E34, E4, E9, F10, F25, F26, F27, F28, F29, F30, F31, F32, F33, F34, F5, F6, F7, F8, F9, G10, G11, G24, G25, G26, G27, G28, G29, G30, G33, G34, G7, G8, G9, H10, H11, H24, H25, H26, H27, H28, H29, H8, H9, J10, J11, J24, J25, J26, J9, K10, K11, K12, K13, K23, K24, K25, K26, L11, L12, L13, L14, L21, L22, L23, L24, L25, L26, M11, M24, M25, M6, M8, M10, N11, P10, P25, P26, R9, T11, U11, W11, Y10, Y11 |

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2M Density Migration](#) for more details.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP

| LFE2-6E/SE | | | | | LFE2-12E/12SE | | | | |
|------------|------------------|------|-------------------|--------------|------------------|------|-------------------|--------------|--|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential | |
| 1 | PL2A | 7 | VREF2_7 | T (LVDS)* | PL2A | 7 | VREF2_7 | T (LVDS)* | |
| 2 | PL2B | 7 | VREF1_7 | C (LVDS)* | PL2B | 7 | VREF1_7 | C (LVDS)* | |
| 3 | PL4A | 7 | | T (LVDS)* | PL4A | 7 | | T (LVDS)* | |
| 4 | PL4B | 7 | | C (LVDS)* | PL4B | 7 | | C (LVDS)* | |
| 5 | PL6A | 7 | LDQ10 | T (LVDS)* | PL6A | 7 | LDQ10 | T (LVDS)* | |
| 6 | VCCAUX | - | | | VCCAUX | - | | | |
| 7 | PL6B | 7 | LDQ10 | C (LVDS)* | PL6B | 7 | LDQ10 | C (LVDS)* | |
| 8 | PL8A | 7 | LDQ10 | T (LVDS)* | PL8A | 7 | LDQ10 | T (LVDS)* | |
| 9 | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| 10 | PL8B | 7 | LDQ10 | C (LVDS)* | PL8B | 7 | LDQ10 | C (LVDS)* | |
| 11 | GND | - | | | GND | - | | | |
| 12 | PL12A | 7 | LDQ10 | T (LVDS)* | PL12A | 7 | LDQ10 | T (LVDS)* | |
| 13 | PL12B | 7 | LDQ10 | C (LVDS)* | PL12B | 7 | LDQ10 | C (LVDS)* | |
| 14 | PL13A | 7 | PCLKT7_0/LDQ10 | T | PL13A | 7 | PCLKT7_0/LDQ10 | T | |
| 15 | PL13B | 7 | PCLKC7_0/LDQ10 | C | PL13B | 7 | PCLKC7_0/LDQ10 | C | |
| 16 | VCC | - | | | VCC | - | | | |
| 17 | PL15A | 6 | PCLKT6_0 | T (LVDS)* | PL15A | 6 | PCLKT6_0 | T (LVDS)* | |
| 18 | PL15B | 6 | PCLKC6_0 | C (LVDS)* | PL15B | 6 | PCLKC6_0 | C (LVDS)* | |
| 19 | PL16A | 6 | VREF2_6 | T | PL16A | 6 | VREF2_6 | T | |
| 20 | PL16B | 6 | VREF1_6 | C | PL16B | 6 | VREF1_6 | C | |
| 21 | GND | - | | | GND | - | | | |
| 22 | VCC | - | | | VCC | - | | | |
| 23 | PL18A | 6 | LLM0_GDLLT_FB_A | T | PL18A | 6 | LLM0_GDLLT_FB_A | T | |
| 24 | PL18B | 6 | LLM0_GDLLC_FB_A | C | PL18B | 6 | LLM0_GDLLC_FB_A | C | |
| 25 | LLM0_PLCCAP | 6 | | | LLM0_PLCCAP | 6 | | | |
| 26 | PL20A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | PL20A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | |
| 27 | PL20B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | PL20B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | |
| 28 | PL22A | 6 | | | PL22A | 6 | | | |
| 29 | VCC | - | | | VCC | - | | | |
| 30 | GND | - | | | GND | - | | | |
| 31 | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| 32 | TCK | - | | | TCK | - | | | |
| 33 | TDI | - | | | TDI | - | | | |
| 34 | TDO | - | | | TDO | - | | | |
| 35 | VCCJ | - | | | VCCJ | - | | | |
| 36 | TMS | - | | | TMS | - | | | |
| 37 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T | |
| 38 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C | |
| 39 | VCCAUX | - | | | VCCAUX | - | | | |
| 40 | PB4A | 5 | BDQ6 | T | PB6A | 5 | BDQS6 | T | |
| 41 | PB4B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C | |
| 42 | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| 43 | PB6A | 5 | BDQS6 | T | PB12A | 5 | BDQ15 | T | |
| 44 | PB6B | 5 | BDQ6 | C | PB12B | 5 | BDQ15 | C | |
| 45 | NC | 5 | | | PB16A | 5 | BDQ15 | T | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/12SE | | | |
|------------|------------------|------|----------------|--------------|------------------|------|----------------|--------------|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential |
| 46 | NC | 5 | | | PB16B | 5 | BDQ15 | C |
| 47 | GND | - | | | GND | - | | |
| 48 | VCC | | | | VCC | - | | |
| 49 | PB8A | 5 | PCLKT5_0/BDQ6 | T | PB26A | 5 | PCLKT5_0/BDQ24 | T |
| 50 | PB8B | 5 | PCLKC5_0/BDQ6 | C | PB26B | 5 | PCLKC5_0/BDQ24 | C |
| 51 | GND | - | | | GND | - | | |
| 52 | PB13A | 4 | PCLKT4_0/BDQ15 | T | PB31A | 4 | PCLKT4_0/BDQ33 | T |
| 53 | PB13B | 4 | PCLKC4_0/BDQ15 | C | PB31B | 4 | PCLKC4_0/BDQ33 | C |
| 54 | VCC | - | | | VCC | - | | |
| 55 | PB14A | 4 | BDQ15 | T | PB34A | 4 | BDQ33 | T |
| 56 | PB14B | 4 | BDQ15 | C | PB34B | 4 | BDQ33 | C |
| 57 | PB16A | 4 | BDQ15 | T | PB40A | 4 | BDQ42 | T |
| 58 | PB16B | 4 | BDQ15 | C | PB40B | 4 | BDQ42 | C |
| 59 | PB18A | 4 | BDQ15 | T | PB44A | 4 | BDQ42 | T |
| 60 | PB18B | 4 | BDQ15 | C | PB44B | 4 | BDQ42 | C |
| 61 | GND | - | | | GND | - | | |
| 62 | PB20A | 4 | BDQ24 | T | PB48A | 4 | BDQ51 | T |
| 63 | PB20B | 4 | BDQ24 | C | PB48B | 4 | BDQ51 | C |
| 64 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| 65 | PB22A | 4 | BDQ24 | T | PB50A | 4 | BDQ51 | T |
| 66 | PB22B | 4 | BDQ24 | C | PB50B | 4 | BDQ51 | C |
| 67 | PB24A | 4 | BDQS24 | T | PB52A | 4 | BDQ51 | T |
| 68 | PB24B | 4 | BDQ24 | C | PB52B | 4 | BDQ51 | C |
| 69 | PB26A | 4 | BDQ24 | T | PB54A | 4 | BDQ51 | T |
| 70 | PB26B | 4 | BDQ24 | C | PB54B | 4 | BDQ51 | C |
| 71 | PB28A | 4 | VREF2_4/BDQ24 | T | PB55A | 4 | VREF2_4/BDQ51 | T |
| 72 | PB28B | 4 | VREF1_4/BDQ24 | C | PB55B | 4 | VREF1_4/BDQ51 | C |
| 73 | CFG1 | 8 | | | CFG1 | 8 | | |
| 74 | CFG2 | 8 | | | CFG2 | 8 | | |
| 75 | PROGRAMN | 8 | | | PROGRAMN | 8 | | |
| 76 | INITN | 8 | | | INITN | 8 | | |
| 77 | CFG0 | 8 | | | CFG0 | 8 | | |
| 78 | CCLK | 8 | | | CCLK | 8 | | |
| 79 | DONE | 8 | | | DONE | 8 | | |
| 80 | PR29A | 8 | D0/SPIFASTN | | PR29A | 8 | D0/SPIFASTN | |
| 81 | GND | - | | | GND | - | | |
| 82 | PR26A | 8 | D6 | | PR26A | 8 | D6 | |
| 83 | VCC | - | | | VCC | - | | |
| 84 | PR25B | 8 | D7/SPID0 | C | PR25B | 8 | D7/SPID0 | C |
| 85 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| 86 | PR25A | 8 | DI/CSSPI0N | T | PR25A | 8 | DI/CSSPI0N | T |
| 87 | PR24B | 8 | DOUT/CSON | C | PR24B | 8 | DOUT/CSON | C |
| 88 | PR24A | 8 | BUSY/SISPI | T | PR24A | 8 | BUSY/SISPI | T |
| 89 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| 90 | VCCAUX | - | | | VCCAUX | - | | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/12SE | | | |
|------------|------------------|------|--------------------|--------------|------------------|------|--------------------|--------------|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential |
| 91 | PR20B | 3 | RLM0_GPLL_C_IN_A** | C (LVDS)* | PR20B | 3 | RLM0_GPLL_C_IN_A** | C (LVDS)* |
| 92 | PR20A | 3 | RLM0_GPLLT_IN_A** | T (LVDS)* | PR20A | 3 | RLM0_GPLLT_IN_A** | T (LVDS)* |
| 93 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| 94 | VCC | - | | | VCC | - | | |
| 95 | GND | - | | | GND | - | | |
| 96 | PR17B | 3 | RLM0_GDLLC_IN_A** | C (LVDS)* | PR17B | 3 | RLM0_GDLLC_IN_A** | C (LVDS)* |
| 97 | PR17A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* | PR17A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* |
| 98 | PR16B | 3 | VREF2_3 | C | PR16B | 3 | VREF2_3 | C |
| 99 | PR16A | 3 | VREF1_3 | T | PR16A | 3 | VREF1_3 | T |
| 100 | PR15B | 3 | PCLKC3_0 | C (LVDS)* | PR15B | 3 | PCLKC3_0 | C (LVDS)* |
| 101 | PR15A | 3 | PCLKT3_0 | T (LVDS)* | PR15A | 3 | PCLKT3_0 | T (LVDS)* |
| 102 | VCC | - | | | VCC | - | | |
| 103 | PR13B | 2 | PCLKC2_0/RDQ10 | C | PR13B | 2 | PCLKC2_0/RDQ10 | C |
| 104 | PR13A | 2 | PCLKT2_0/RDQ10 | T | PR13A | 2 | PCLKT2_0/RDQ10 | T |
| 105 | GND | - | | | GND | - | | |
| 106 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| 107 | PR2B | 2 | VREF2_2 | C (LVDS)* | PR2B | 2 | VREF2_2 | C (LVDS)* |
| 108 | PR2A | 2 | VREF1_2 | T (LVDS)* | PR2A | 2 | VREF1_2 | T (LVDS)* |
| 109 | PT28B | 1 | VREF2_1 | C | PT55B | 1 | VREF2_1 | C |
| 110 | PT28A | 1 | VREF1_1 | T | PT55A | 1 | VREF1_1 | T |
| 111 | PT26B | 1 | | C | PT54B | 1 | | C |
| 112 | PT26A | 1 | | T | PT54A | 1 | | T |
| 113 | PT24B | 1 | | C | PT52B | 1 | | C |
| 114 | PT24A | 1 | | T | PT52A | 1 | | T |
| 115 | PT22B | 1 | | C | PT50B | 1 | | C |
| 116 | PT22A | 1 | | T | PT50A | 1 | | T |
| 117 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| 118 | PT20B | 1 | | C | PT48B | 1 | | C |
| 119 | PT20A | 1 | | T | PT48A | 1 | | T |
| 120 | GND | - | | | GND | - | | |
| 121 | PT18B | 1 | | C | PT44B | 1 | | C |
| 122 | PT18A | 1 | | T | PT44A | 1 | | T |
| 123 | PT16A | 1 | | | PT40B | 1 | | C |
| 124 | NC | 1 | | | PT40A | 1 | | T |
| 125 | PT14B | 1 | | C | PT34B | 1 | | C |
| 126 | PT14A | 1 | | T | PT34A | 1 | | T |
| 127 | NC | 1 | | | NC | 1 | | |
| 128 | VCC | - | | | VCC | - | | |
| 129 | PT12B | 1 | PCLKC1_0 | C | PT30B | 1 | PCLKC1_0 | C |
| 130 | PT12A | 1 | PCLKT1_0 | T | PT30A | 1 | PCLKT1_0 | T |
| 131 | PT10B | 0 | PCLKC0_0 | C | PT28B | 0 | PCLKC0_0 | C |
| 132 | XRES | 0 | | | XRES | 0 | | |
| 133 | GND | - | | | GND | - | | |
| 134 | PT10A | 0 | PCLKT0_0 | T | PT28A | 0 | PCLKT0_0 | T |
| 135 | VCC | - | | | VCC | - | | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/12SE | | | |
|------------|------------------|------|---------------|--------------|------------------|------|---------------|--------------|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential |
| 136 | PT6B | 0 | | C | PT16B | 0 | | C |
| 137 | PT6A | 0 | | T | PT16A | 0 | | T |
| 138 | GND | - | | | GND | - | | |
| 139 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| 140 | PT4B | 0 | | C | PT6B | 0 | | C |
| 141 | PT4A | 0 | | T | PT6A | 0 | | T |
| 142 | VCCAUX | - | | | VCCAUX | - | | |
| 143 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| 144 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP

| LFE2-12E/SE | | | | | LFE2-20E/SE | | | | |
|-------------|------------------|------|-------------------|--------------|------------------|------|-------------------------|--------------|--|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential | |
| 1 | PL2A | 7 | VREF2_7 | T (LVDS)* | PL2A | 7 | VREF2_7 | T (LVDS)* | |
| 2 | PL2B | 7 | VREF1_7 | C (LVDS)* | PL2B | 7 | VREF1_7 | C (LVDS)* | |
| 3 | PL4A | 7 | | T (LVDS)* | PL6A | 7 | LDQ8 | T (LVDS)* | |
| 4 | PL4B | 7 | | C (LVDS)* | PL6B | 7 | LDQ8 | C (LVDS)* | |
| 5 | GND | - | | | GND | - | | | |
| 6 | PL6A | 7 | LDQ10 | T (LVDS)* | PL12A | 7 | LDQ16 | T (LVDS)* | |
| 7 | VCCAUX | - | | | VCCAUX | - | | | |
| 8 | PL6B | 7 | LDQ10 | C (LVDS)* | PL12B | 7 | LDQ16 | C (LVDS)* | |
| 9 | PL8A | 7 | LDQ10 | T (LVDS)* | PL14A | 7 | LDQ16 | T (LVDS)* | |
| 10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| 11 | PL8B | 7 | LDQ10 | C (LVDS)* | PL14B | 7 | LDQ16 | C (LVDS)* | |
| 12 | VCC | - | | | VCC | - | | | |
| 13 | GND | - | | | GND | - | | | |
| 14 | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| 15 | PL12A | 7 | LDQ10 | T (LVDS)* | PL18A | 7 | LDQ16 | T (LVDS)* | |
| 16 | PL12B | 7 | LDQ10 | C (LVDS)* | PL18B | 7 | LDQ16 | C (LVDS)* | |
| 17 | GND | - | | | GND | - | | | |
| 18 | PL13A | 7 | PCLKT7_0/LDQ10 | T | PL19A | 7 | PCLKT7_0/LDQ16 | T | |
| 19 | VCC | - | | | VCC | - | | | |
| 20 | PL13B | 7 | PCLKC7_0/LDQ10 | C | PL19B | 7 | PCLKC7_0/LDQ16 | C | |
| 21 | PL15A | 6 | PCLKT6_0 | T (LVDS)* | PL21A | 6 | PCLKT6_0/LDQ25 | T (LVDS)* | |
| 22 | PL15B | 6 | PCLKC6_0 | C (LVDS)* | PL21B | 6 | PCLKC6_0/LDQ25 | C (LVDS)* | |
| 23 | PL16A | 6 | VREF2_6 | T | PL22A | 6 | VREF2_6/LDQ25 | T | |
| 24 | PL16B | 6 | VREF1_6 | C | PL22B | 6 | VREF1_6/LDQ25 | C | |
| 25 | GND | - | | | GND | - | | | |
| 26 | PL17A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* | PL27A | 6 | LLM0_GDLLT_IN_A**/LDQ25 | T (LVDS)* | |
| 27 | PL17B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* | PL27B | 6 | LLM0_GDLLC_IN_A**/LDQ25 | C (LVDS)* | |
| 28 | VCC | - | | | VCC | - | | | |
| 29 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | | |
| 30 | VCCAUX | - | | | VCCAUX | - | | | |
| 31 | PL20A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | PL30A | 6 | LLM0_GPLLT_IN_A**/LDQ34 | T (LVDS)* | |
| 32 | GND | - | | | GND | - | | | |
| 33 | PL21A | 6 | LLM0_GPLLT_FB_A | T | PL31A | 6 | LLM0_GPLLT_FB_A/LDQ34 | T | |
| 34 | PL20B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | PL30B | 6 | LLM0_GPLLC_IN_A**/LDQ34 | C (LVDS)* | |
| 35 | PL21B | 6 | LLM0_GPLLC_FB_A | C | PL31B | 6 | LLM0_GPLLC_FB_A/LDQ34 | C | |
| 36 | PL23A | 6 | | | PL33A | 6 | LDQ34 | | |
| 37 | PL24A | 6 | LDQ28 | T (LVDS)* | PL38A | 6 | LDQ42 | T (LVDS)* | |
| 38 | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| 39 | PL24B | 6 | LDQ28 | C (LVDS)* | PL38B | 6 | LDQ42 | C (LVDS)* | |
| 40 | VCC | - | | | VCC | - | | | |
| 41 | PL26A | 6 | LDQ28 | T (LVDS)* | PL40A | 6 | LDQ42 | T (LVDS)* | |
| 42 | GND | - | | | GND | - | | | |
| 43 | PL26B | 6 | LDQ28 | C (LVDS)* | PL40B | 6 | LDQ42 | C (LVDS)* | |
| 44 | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| 45 | PL28A | 6 | LDQS28 | T (LVDS)* | PL42A | 6 | LDQS42 | T (LVDS)* | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

| LFE2-12E/SE | | | | | LFE2-20E/SE | | | |
|-------------|------------------|------|----------------|--------------|------------------|------|----------------|--------------|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential |
| 46 | PL28B | 6 | LDQ28 | C (LVDS)* | PL42B | 6 | LDQ42 | C (LVDS)* |
| 47 | PL30A | 6 | LDQ28 | | PL44A | 6 | LDQ42 | |
| 48 | TCK | - | | | TCK | - | | |
| 49 | TDI | - | | | TDI | - | | |
| 50 | TDO | - | | | TDO | - | | |
| 51 | VCCJ | - | | | VCCJ | - | | |
| 52 | TMS | - | | | TMS | - | | |
| 53 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T |
| 54 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C |
| 55 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| 56 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T |
| 57 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C |
| 58 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T |
| 59 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C |
| 60 | GND | - | | | GND | - | | |
| 61 | PB12A | 5 | BDQ15 | T | PB12A | 5 | BDQ15 | T |
| 62 | PB12B | 5 | BDQ15 | C | PB12B | 5 | BDQ15 | C |
| 63 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| 64 | PB16A | 5 | BDQ15 | T | PB16A | 5 | BDQ15 | T |
| 65 | PB16B | 5 | BDQ15 | C | PB16B | 5 | BDQ15 | C |
| 66 | PB18A | 5 | BDQ15 | T | PB18A | 5 | BDQ15 | T |
| 67 | PB18B | 5 | BDQ15 | C | PB18B | 5 | BDQ15 | C |
| 68 | GND | - | | | GND | - | | |
| 69 | PB20A | 5 | BDQ24 | T | PB30A | 5 | BDQ33 | T |
| 70 | VCCAUX | - | | | VCCAUX | - | | |
| 71 | PB20B | 5 | BDQ24 | C | PB30B | 5 | BDQ33 | C |
| 72 | PB22A | 5 | BDQ24 | T | PB32A | 5 | BDQ33 | T |
| 73 | PB22B | 5 | BDQ24 | C | PB32B | 5 | BDQ33 | C |
| 74 | VCC | - | | | VCC | - | | |
| 75 | PB26A | 5 | PCLKT5_0/BDQ24 | T | PB35A | 5 | PCLKT5_0/BDQ33 | T |
| 76 | PB26B | 5 | PCLKC5_0/BDQ24 | C | PB35B | 5 | PCLKC5_0/BDQ33 | C |
| 77 | GND | - | | | GND | - | | |
| 78 | PB31A | 4 | PCLKT4_0/BDQ33 | T | PB40A | 4 | PCLKT4_0/BDQ42 | T |
| 79 | PB31B | 4 | PCLKC4_0/BDQ33 | C | PB40B | 4 | PCLKC4_0/BDQ42 | C |
| 80 | VCC | - | | | VCC | - | | |
| 81 | GND | - | | | GND | - | | |
| 82 | PB34A | 4 | BDQ33 | T | PB42A | 4 | BDQS42 | T |
| 83 | PB34B | 4 | BDQ33 | C | PB42B | 4 | BDQ42 | C |
| 84 | PB36A | 4 | BDQ33 | T | PB44A | 4 | BDQ42 | T |
| 85 | PB36B | 4 | BDQ33 | C | PB44B | 4 | BDQ42 | C |
| 86 | VCCAUX | - | | | VCCAUX | - | | |
| 87 | PB40A | 4 | BDQ42 | T | PB50A | 4 | BDQ51 | T |
| 88 | PB40B | 4 | BDQ42 | C | PB50B | 4 | BDQ51 | C |
| 89 | GND | - | | | GND | - | | |
| 90 | PB42A | 4 | BDQS42 | T | PB52A | 4 | BDQ51 | T |
| 91 | PB42B | 4 | BDQ42 | C | PB52B | 4 | BDQ51 | C |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

| LFE2-12E/SE | | | | | LFE2-20E/SE | | | | |
|-------------|------------------|------|--------------------|--------------|------------------|------|--------------------------|--------------|--|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential | |
| 92 | PB44A | 4 | BDQ42 | T | PB54A | 4 | BDQ51 | T | |
| 93 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| 94 | PB44B | 4 | BDQ42 | C | PB54B | 4 | BDQ51 | C | |
| 95 | PB48A | 4 | BDQ51 | T | PB58A | 4 | BDQ60 | T | |
| 96 | PB48B | 4 | BDQ51 | C | PB58B | 4 | BDQ60 | C | |
| 97 | VCC | - | | | VCC | - | | | |
| 98 | PB52A | 4 | BDQ51 | T | PB60A | 4 | BDQS60 | T | |
| 99 | PB52B | 4 | BDQ51 | C | PB60B | 4 | BDQ60 | C | |
| 100 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| 101 | PB54A | 4 | BDQ51 | | PB63A | 4 | BDQ60 | | |
| 102 | GND | - | | | GND | - | | | |
| 103 | PB55A | 4 | VREF2_4/BDQ51 | T | PB64A | 4 | VREF2_4/BDQ60 | T | |
| 104 | PB55B | 4 | VREF1_4/BDQ51 | C | PB64B | 4 | VREF1_4/BDQ60 | C | |
| 105 | CFG1 | 8 | | | CFG1 | 8 | | | |
| 106 | PROGRAMN | 8 | | | PROGRAMN | 8 | | | |
| 107 | CFG2 | 8 | | | CFG2 | 8 | | | |
| 108 | INITN | 8 | | | INITN | 8 | | | |
| 109 | CFG0 | 8 | | | CFG0 | 8 | | | |
| 110 | CCLK | 8 | | | CCLK | 8 | | | |
| 111 | DONE | 8 | | | DONE | 8 | | | |
| 112 | PR29A | 8 | D0/SPIFASTN | | PR43A | 8 | D0/SPIFASTN | | |
| 113 | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| 114 | PR26A | 8 | D6 | | PR40A | 8 | D6 | | |
| 115 | GND | - | | | GND | - | | | |
| 116 | VCC | - | | | VCC | - | | | |
| 117 | PR25B | 8 | D7/SPID0 | C | PR39B | 8 | D7/SPID0 | C | |
| 118 | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| 119 | PR25A | 8 | DI/CSSPI0N | T | PR39A | 8 | DI/CSSPI0N | T | |
| 120 | PR24B | 8 | DOU/CSON | C | PR38B | 8 | DOU/CSON | C | |
| 121 | PR24A | 8 | BUSY/SISPI | T | PR38A | 8 | BUSY/SISPI | T | |
| 122 | GND | - | | | GND | - | | | |
| 123 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| 124 | PR21A | 3 | RLM0_GPLLT_FB_A | | PR31A | 3 | RLM0_GPLLT_FB_A/RDQ34 | | |
| 125 | VCCAUX | - | | | VCCAUX | - | | | |
| 126 | PR20B | 3 | RLM0_GPLL_C_IN_A** | C (LVDS)* | PR30B | 3 | RLM0_GPLL_C_IN_A**/RDQ34 | C (LVDS)* | |
| 127 | PR20A | 3 | RLM0_GPLL_T_IN_A** | T (LVDS)* | PR30A | 3 | RLM0_GPLL_T_IN_A**/RDQ34 | T (LVDS)* | |
| 128 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | | |
| 129 | VCC | - | | | VCC | - | | | |
| 130 | PR18B | 3 | RLM0_GDLL_C_FB_A | C | PR28B | 3 | RLM0_GDLL_C_FB_A/RDQ25 | C | |
| 131 | PR18A | 3 | RLM0_GDLL_T_FB_A | T | PR28A | 3 | RLM0_GDLL_T_FB_A/RDQ25 | T | |
| 132 | PR17B | 3 | RLM0_GDLL_C_IN_A** | C (LVDS)* | PR27B | 3 | RLM0_GDLL_C_IN_A**/RDQ25 | C (LVDS)* | |
| 133 | PR17A | 3 | RLM0_GDLL_T_IN_A** | T (LVDS)* | PR27A | 3 | RLM0_GDLL_T_IN_A**/RDQ25 | T (LVDS)* | |
| 134 | PR16B | 3 | VREF2_3 | C | PR22B | 3 | VREF2_3/RDQ25 | C | |
| 135 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| 136 | PR16A | 3 | VREF1_3 | T | PR22A | 3 | VREF1_3/RDQ25 | T | |
| 137 | PR15B | 3 | PCLKC3_0 | C (LVDS)* | PR21B | 3 | PCLKC3_0/RDQ25 | C (LVDS)* | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

| LFE2-12E/SE | | | | | LFE2-20E/SE | | | | |
|-------------|------------------|------|----------------|--------------|------------------|------|----------------|--------------|--|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential | |
| 138 | PR15A | 3 | PCLKT3_0 | T (LVDS)* | PR21A | 3 | PCLKT3_0/RDQ25 | T (LVDS)* | |
| 139 | GND | - | | | GND | - | | | |
| 140 | VCC | - | | | VCC | - | | | |
| 141 | PR13B | 2 | PCLKC2_0/RDQ10 | C | PR19B | 2 | PCLKC2_0/RDQ16 | C | |
| 142 | PR13A | 2 | PCLKT2_0/RDQ10 | T | PR19A | 2 | PCLKT2_0/RDQ16 | T | |
| 143 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| 144 | PR12A | 2 | RDQ10 | | PR16A | 2 | RDQS16 | | |
| 145 | GND | - | | | GND | - | | | |
| 146 | VCC | - | | | VCC | - | | | |
| 147 | PR8B | 2 | RDQ10 | C (LVDS)* | PR14B | 2 | RDQ16 | C (LVDS)* | |
| 148 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| 149 | PR8A | 2 | RDQ10 | T (LVDS)* | PR14A | 2 | RDQ16 | T (LVDS)* | |
| 150 | PR6B | 2 | RDQ10 | C (LVDS)* | PR12B | 2 | RDQ16 | C (LVDS)* | |
| 151 | VCCAUX | - | | | VCCAUX | - | | | |
| 152 | PR6A | 2 | RDQ10 | T (LVDS)* | PR12A | 2 | RDQ16 | T (LVDS)* | |
| 153 | PR4B | 2 | | C (LVDS)* | PR6B | 2 | RDQ8 | C (LVDS)* | |
| 154 | PR4A | 2 | | T (LVDS)* | PR6A | 2 | RDQ8 | T (LVDS)* | |
| 155 | PR2B | 2 | VREF2_2 | C (LVDS)* | PR2B | 2 | VREF2_2 | C (LVDS)* | |
| 156 | PR2A | 2 | VREF1_2 | T (LVDS)* | PR2A | 2 | VREF1_2 | T (LVDS)* | |
| 157 | PT55B | 1 | VREF2_1 | C | PT64B | 1 | VREF2_1 | C | |
| 158 | PT55A | 1 | VREF1_1 | T | PT64A | 1 | VREF1_1 | T | |
| 159 | GND | - | | | GND | - | | | |
| 160 | PT54B | 1 | | C | PT62B | 1 | | C | |
| 161 | PT54A | 1 | | T | PT62A | 1 | | T | |
| 162 | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| 163 | PT52B | 1 | | C | PT60B | 1 | | C | |
| 164 | PT52A | 1 | | T | PT60A | 1 | | T | |
| 165 | PT50B | 1 | | C | PT58B | 1 | | C | |
| 166 | PT50A | 1 | | T | PT58A | 1 | | T | |
| 167 | PT48B | 1 | | C | PT56B | 1 | | C | |
| 168 | PT48A | 1 | | T | PT56A | 1 | | T | |
| 169 | GND | - | | | GND | - | | | |
| 170 | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| 171 | VCC | - | | | VCC | - | | | |
| 172 | PT40B | 1 | | C | PT50B | 1 | | C | |
| 173 | PT40A | 1 | | T | PT50A | 1 | | T | |
| 174 | VCCAUX | - | | | VCCAUX | - | | | |
| 175 | GND | - | | | GND | - | | | |
| 176 | PT36B | 1 | | C | PT44B | 1 | | C | |
| 177 | PT36A | 1 | | T | PT44A | 1 | | T | |
| 178 | PT34B | 1 | | C | PT42B | 1 | | C | |
| 179 | PT34A | 1 | | T | PT42A | 1 | | T | |
| 180 | PT30B | 1 | PCLKC1_0 | C | PT39B | 1 | PCLKC1_0 | C | |
| 181 | PT30A | 1 | PCLKT1_0 | T | PT39A | 1 | PCLKT1_0 | T | |
| 182 | XRES | 1 | | | XRES | 1 | | | |
| 183 | PT28B | 0 | PCLKC0_0 | C | PT37B | 0 | PCLKC0_0 | C | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

| LFE2-12E/SE | | | | | LFE2-20E/SE | | | |
|-------------|------------------|------|---------------|--------------|------------------|------|---------------|--------------|
| Pin Number | Pin/Pad Function | Bank | Dual Function | Differential | Pin/Pad Function | Bank | Dual Function | Differential |
| 184 | GND | - | | | GND | - | | |
| 185 | PT28A | 0 | PCLKT0_0 | T | PT37A | 0 | PCLKT0_0 | T |
| 186 | PT26B | 0 | | C | PT36B | 0 | | C |
| 187 | PT26A | 0 | | T | PT36A | 0 | | T |
| 188 | VCC | - | | | VCC | - | | |
| 189 | PT20B | 0 | | C | PT30B | 0 | | C |
| 190 | VCCAUX | - | | | VCCAUX | - | | |
| 191 | PT20A | 0 | | T | PT30A | 0 | | T |
| 192 | GND | - | | | GND | - | | |
| 193 | PT18B | 0 | | C | PT26B | 0 | | C |
| 194 | PT18A | 0 | | T | PT26A | 0 | | T |
| 195 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| 196 | PT16B | 0 | | C | PT20B | 0 | | C |
| 197 | PT16A | 0 | | T | PT20A | 0 | | T |
| 198 | VCC | - | | | VCC | - | | |
| 199 | PT12B | 0 | | C | PT12B | 0 | | C |
| 200 | PT12A | 0 | | T | PT12A | 0 | | T |
| 201 | GND | - | | | GND | - | | |
| 202 | PT8B | 0 | | C | PT8B | 0 | | C |
| 203 | PT8A | 0 | | T | PT8A | 0 | | T |
| 204 | PT6B | 0 | | C | PT6B | 0 | | C |
| 205 | PT6A | 0 | | T | PT6A | 0 | | T |
| 206 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| 207 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| 208 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | | |
|-------------|-------------------|------|-------------------|--------------|-------------------|------|-------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| C3 | PL2A | 7 | VREF2_7 | T (LVDS)* | PL2A | 7 | VREF2_7 | T (LVDS)* | |
| C2 | PL2B | 7 | VREF1_7 | C (LVDS)* | PL2B | 7 | VREF1_7 | C (LVDS)* | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| - | - | - | | | - | - | | | |
| D3 | PL5A | 7 | | T | PL5A | 7 | | T | |
| D4 | PL4A | 7 | | T (LVDS)* | PL4A | 7 | | T (LVDS)* | |
| D2 | PL5B | 7 | | C | PL5B | 7 | | C | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| E4 | PL4B | 7 | | C (LVDS)* | PL4B | 7 | | C (LVDS)* | |
| B1 | PL7A | 7 | LDQ10 | T | PL7A | 7 | LDQ10 | T | |
| C1 | PL7B | 7 | LDQ10 | C | PL7B | 7 | LDQ10 | C | |
| F5 | PL9A | 7 | LDQ10 | T | PL9A | 7 | LDQ10 | T | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| F4 | PL8A | 7 | LDQ10 | T (LVDS)* | PL8A | 7 | LDQ10 | T (LVDS)* | |
| G6 | PL9B | 7 | LDQ10 | C | PL9B | 7 | LDQ10 | C | |
| G4 | PL8B | 7 | LDQ10 | C (LVDS)* | PL8B | 7 | LDQ10 | C (LVDS)* | |
| D1 | PL10A | 7 | LDQS10 | T (LVDS)* | PL10A | 7 | LDQS10 | T (LVDS)* | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| E1 | PL10B | 7 | LDQ10 | C (LVDS)* | PL10B | 7 | LDQ10 | C (LVDS)* | |
| F3 | PL11A | 7 | LDQ10 | T | PL11A | 7 | LDQ10 | T | |
| G3 | PL11B | 7 | LDQ10 | C | PL11B | 7 | LDQ10 | C | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| F2 | PL12A | 7 | LDQ10 | T (LVDS)* | PL12A | 7 | LDQ10 | T (LVDS)* | |
| F1 | PL12B | 7 | LDQ10 | C (LVDS)* | PL12B | 7 | LDQ10 | C (LVDS)* | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| G2 | PL13A | 7 | PCLKT7_0/LDQ10 | T | PL13A | 7 | PCLKT7_0/LDQ10 | T | |
| G1 | PL13B | 7 | PCLKC7_0/LDQ10 | C | PL13B | 7 | PCLKC7_0/LDQ10 | C | |
| H6 | PL15A | 6 | PCLKT6_0 | T (LVDS)* | PL15A | 6 | PCLKT6_0 | T (LVDS)* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| H5 | PL15B | 6 | PCLKC6_0 | C (LVDS)* | PL15B | 6 | PCLKC6_0 | C (LVDS)* | |
| H4 | PL16A | 6 | VREF2_6 | T | PL16A | 6 | VREF2_6 | T | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| H3 | PL16B | 6 | VREF1_6 | C | PL16B | 6 | VREF1_6 | C | |
| H2 | PL17A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* | PL17A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* | |
| H1 | PL17B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* | PL17B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* | |
| G10 | VCC | - | | | VCC | - | | | |
| J4 | PL18A | 6 | LLM0_GDLLT_FB_A | T | PL18A | 6 | LLM0_GDLLT_FB_A | T | |
| J5 | PL18B | 6 | LLM0_GDLLC_FB_A | C | PL18B | 6 | LLM0_GDLLC_FB_A | C | |
| J6 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | | |
| K4 | PL20A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | PL20A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| J1 | PL21A | 6 | LLM0_GPLLT_FB_A | T | PL21A | 6 | LLM0_GPLLT_FB_A | T | |
| K3 | PL20B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | PL20B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| J2 | PL21B | 6 | LLM0_GPLLC_FB_A | C | PL21B | 6 | LLM0_GPLLC_FB_A | C | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| L2 | PL24A | 6 | LDQ28 | T (LVDS)* | PL24A | 6 | LDQ28 | T (LVDS)* |
| K2 | PL25A | 6 | LDQ28 | T | PL25A | 6 | LDQ28 | T |
| L3 | PL24B | 6 | LDQ28 | C (LVDS)* | PL24B | 6 | LDQ28 | C (LVDS)* |
| K1 | PL25B | 6 | LDQ28 | C | PL25B | 6 | LDQ28 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| L4 | PL26A | 6 | LDQ28 | T (LVDS)* | PL26A | 6 | LDQ28 | T (LVDS)* |
| L1 | PL27A | 6 | LDQ28 | T | PL27A | 6 | LDQ28 | T |
| L5 | PL26B | 6 | LDQ28 | C (LVDS)* | PL26B | 6 | LDQ28 | C (LVDS)* |
| M1 | PL27B | 6 | LDQ28 | C | PL27B | 6 | LDQ28 | C |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| N1 | PL29A | 6 | LDQ28 | T | PL29A | 6 | LDQ28 | T |
| N2 | PL28A | 6 | LDQS28 | T (LVDS)* | PL28A | 6 | LDQS28 | T (LVDS)* |
| P1 | PL29B | 6 | LDQ28 | C | PL29B | 6 | LDQ28 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| P2 | PL28B | 6 | LDQ28 | C (LVDS)* | PL28B | 6 | LDQ28 | C (LVDS)* |
| R1 | PL30A | 6 | LDQ28 | T (LVDS)* | PL30A | 6 | LDQ28 | T (LVDS)* |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| R2 | PL30B | 6 | LDQ28 | C (LVDS)* | PL30B | 6 | LDQ28 | C (LVDS)* |
| N4 | TDI | - | | | TDI | - | | |
| M4 | TCK | - | | | TCK | - | | |
| P3 | TDO | - | | | TDO | - | | |
| N3 | TMS | - | | | TMS | - | | |
| K7 | VCCJ | - | | | VCCJ | - | | |
| M5 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T |
| K6 | NC | - | | | PB3A | 5 | BDQ6 | |
| M6 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C |
| R3 | NC | - | | | PB5A | 5 | BDQ6 | T |
| P4 | NC | - | | | PB5B | 5 | BDQ6 | C |
| - | - | - | | | VCCIO | 5 | | |
| - | - | - | | | GNDIO5 | 5 | | |
| N5 | PB3A | 5 | BDQ6 | T | PB21A | 5 | BDQ24 | T |
| N6 | PB3B | 5 | BDQ6 | C | PB21B | 5 | BDQ24 | C |
| T2 | PB4A | 5 | BDQ6 | T | PB22A | 5 | BDQ24 | T |
| P6 | PB5A | 5 | BDQ6 | T | PB23A | 5 | BDQ24 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T3 | PB4B | 5 | BDQ6 | C | PB22B | 5 | BDQ24 | C |
| R6 | PB5B | 5 | BDQ6 | C | PB23B | 5 | BDQ24 | C |
| GND | GNDIO5 | - | | | GNDIO5 | - | | |
| R4 | PB6A | 5 | BDQS6 | T | PB24A | 5 | BDQS24 | T |
| L6 | PB7A | 5 | BDQ6 | T | PB25A | 5 | BDQ24 | T |
| T4 | PB6B | 5 | BDQ6 | C | PB24B | 5 | BDQ24 | C |
| L7 | PB7B | 5 | BDQ6 | C | PB25B | 5 | BDQ24 | C |
| N7 | PB8A | 5 | PCLKT5_0/BDQ6 | T | PB26A | 5 | PCLKT5_0/BDQ24 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| M8 | PB8B | 5 | PCLKC5_0/BDQ6 | C | PB26B | 5 | PCLKC5_0/BDQ24 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| P7 | PB13A | 4 | PCLKT4_0/BDQ15 | T | PB31A | 4 | PCLKT4_0/BDQ33 | T | |
| R8 | PB13B | 4 | PCLKC4_0/BDQ15 | C | PB31B | 4 | PCLKC4_0/BDQ33 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| T5 | PB14A | 4 | BDQ15 | T | PB32A | 4 | BDQ33 | T | |
| T6 | PB14B | 4 | BDQ15 | C | PB32B | 4 | BDQ33 | C | |
| T8 | PB15A | 4 | BDQS15 | T | PB33A | 4 | BDQS33 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| R7 | PB16A | 4 | BDQ15 | T | PB34A | 4 | BDQ33 | T | |
| T9 | PB15B | 4 | BDQ15 | C | PB33B | 4 | BDQ33 | C | |
| T7 | PB16B | 4 | BDQ15 | C | PB34B | 4 | BDQ33 | C | |
| L8 | PB17A | 4 | BDQ15 | T | PB35A | 4 | BDQ33 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| P8 | PB18A | 4 | BDQ15 | T | PB36A | 4 | BDQ33 | T | |
| L9 | PB17B | 4 | BDQ15 | C | PB35B | 4 | BDQ33 | C | |
| N8 | PB18B | 4 | BDQ15 | C | PB36B | 4 | BDQ33 | C | |
| R9 | PB19A | 4 | BDQ15 | T | PB37A | 4 | BDQ33 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| R10 | PB19B | 4 | BDQ15 | C | PB37B | 4 | BDQ33 | C | |
| - | - | - | | | VCCIO | 4 | | | |
| - | - | - | | | GNDIO4 | 4 | | | |
| N9 | PB20A | 4 | BDQ24 | T | PB47A | 4 | BDQ51 | T | |
| T10 | PB21A | 4 | BDQ24 | T | PB48A | 4 | BDQ51 | T | |
| M9 | PB20B | 4 | BDQ24 | C | PB47B | 4 | BDQ51 | C | |
| R11 | PB21B | 4 | BDQ24 | C | PB48B | 4 | BDQ51 | C | |
| P10 | PB22A | 4 | BDQ24 | T | PB49A | 4 | BDQ51 | T | |
| N11 | PB23A | 4 | BDQ24 | T | PB50A | 4 | BDQ51 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| N10 | PB22B | 4 | BDQ24 | C | PB49B | 4 | BDQ51 | C | |
| P11 | PB23B | 4 | BDQ24 | C | PB50B | 4 | BDQ51 | C | |
| T11 | PB24A | 4 | BDQS24 | T | PB51A | 4 | BDQS51 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| M11 | PB25A | 4 | BDQ24 | T | PB52A | 4 | BDQ51 | T | |
| T12 | PB24B | 4 | BDQ24 | C | PB51B | 4 | BDQ51 | C | |
| L11 | PB25B | 4 | BDQ24 | C | PB52B | 4 | BDQ51 | C | |
| T13 | PB26A | 4 | BDQ24 | T | PB53A | 4 | BDQ51 | T | |
| R13 | PB27A | 4 | BDQ24 | T | PB54A | 4 | BDQ51 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| T14 | PB26B | 4 | BDQ24 | C | PB53B | 4 | BDQ51 | C | |
| P13 | PB27B | 4 | BDQ24 | C | PB54B | 4 | BDQ51 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| N12 | PB28A | 4 | VREF2_4/BDQ24 | T | PB55A | 4 | VREF2_4/BDQ51 | T | |
| M12 | PB28B | 4 | VREF1_4/BDQ24 | C | PB55B | 4 | VREF1_4/BDQ51 | C | |
| R15 | CFG2 | 8 | | | CFG2 | 8 | | | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | |
|-------------|-------------------|------|--------------------|--------------|-------------------|------|--------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| N14 | CFG1 | 8 | | | CFG1 | 8 | | |
| N13 | PROGRAMN | 8 | | | PROGRAMN | 8 | | |
| N15 | CFG0 | 8 | | | CFG0 | 8 | | |
| P15 | PR30B | 8 | WRITEN | C | PR30B | 8 | WRITEN | C |
| L12 | INITN | 8 | | | INITN | 8 | | |
| N16 | PR29B | 8 | CSN | C | PR29B | 8 | CSN | C |
| GND | GNDIO8 | - | | | GNDIO8 | - | | |
| R14 | CCLK | 8 | | | CCLK | 8 | | |
| P14 | PR30A | 8 | CS1N | T | PR30A | 8 | CS1N | T |
| M13 | DONE | 8 | | | DONE | 8 | | |
| R16 | PR28B | 8 | D1 | C | PR28B | 8 | D1 | C |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| M16 | PR29A | 8 | D0/SPIFASTN | T | PR29A | 8 | D0/SPIFASTN | T |
| P16 | PR28A | 8 | D2 | T | PR28A | 8 | D2 | T |
| L15 | PR27B | 8 | D3 | C | PR27B | 8 | D3 | C |
| GND | GNDIO8 | - | | | GNDIO8 | - | | |
| L14 | PR26A | 8 | D6 | T | PR26A | 8 | D6 | T |
| L16 | PR27A | 8 | D4 | T | PR27A | 8 | D4 | T |
| L10 | PR25B | 8 | D7/SPID0 | C | PR25B | 8 | D7/SPID0 | C |
| L13 | PR26B | 8 | D5 | C | PR26B | 8 | D5 | C |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| K11 | PR25A | 8 | DI/CSSPI0N | T | PR25A | 8 | DI/CSSPI0N | T |
| K14 | PR24B | 8 | DOUT/CSON | C | PR24B | 8 | DOUT/CSON | C |
| K13 | PR24A | 8 | BUSY/SISPI | T | PR24A | 8 | BUSY/SISPI | T |
| GND | GNDIO8 | - | | | GNDIO8 | - | | |
| K15 | PR21B | 3 | RLM0_GPLL_C_FB_A | C | PR21B | 3 | RLM0_GPLL_C_FB_A | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| K16 | PR21A | 3 | RLM0_GPLL_T_FB_A | T | PR21A | 3 | RLM0_GPLL_T_FB_A | T |
| GND | GNDIO3 | - | | | GNDIO3 | - | | |
| J16 | PR20B | 3 | RLM0_GPLL_C_IN_A** | C (LVDS)* | PR20B | 3 | RLM0_GPLL_C_IN_A** | C (LVDS)* |
| J15 | PR20A | 3 | RLM0_GPLL_T_IN_A** | T (LVDS)* | PR20A | 3 | RLM0_GPLL_T_IN_A** | T (LVDS)* |
| J14 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| J13 | PR18B | 3 | RLM0_GDLL_C_FB_A | C | PR18B | 3 | RLM0_GDLL_C_FB_A | C |
| J12 | PR18A | 3 | RLM0_GDLL_T_FB_A | T | PR18A | 3 | RLM0_GDLL_T_FB_A | T |
| H12 | PR17B | 3 | RLM0_GDLL_C_IN_A** | C (LVDS)* | PR17B | 3 | RLM0_GDLL_C_IN_A** | C (LVDS)* |
| GND | GNDIO3 | - | | | GNDIO3 | - | | |
| H13 | PR17A | 3 | RLM0_GDLL_T_IN_A** | T (LVDS)* | PR17A | 3 | RLM0_GDLL_T_IN_A** | T (LVDS)* |
| H15 | PR16B | 3 | VREF2_3 | C | PR16B | 3 | VREF2_3 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| H16 | PR16A | 3 | VREF1_3 | T | PR16A | 3 | VREF1_3 | T |
| H11 | PR15B | 3 | PCLKC3_0 | C (LVDS)* | PR15B | 3 | PCLKC3_0 | C (LVDS)* |
| J11 | PR15A | 3 | PCLKT3_0 | T (LVDS)* | PR15A | 3 | PCLKT3_0 | T (LVDS)* |
| G16 | PR13B | 2 | PCLKC2_0/RDQ10 | C | PR13B | 2 | PCLKC2_0/RDQ10 | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| G15 | PR13A | 2 | PCLKT2_0/RDQ10 | T | PR13A | 2 | PCLKT2_0/RDQ10 | T |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F15 | PR11B | 2 | RDQ10 | C | PR11B | 2 | RDQ10 | C |
| G11 | PR12B | 2 | RDQ10 | C (LVDS)* | PR12B | 2 | RDQ10 | C (LVDS)* |
| F14 | PR11A | 2 | RDQ10 | T | PR11A | 2 | RDQ10 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| F12 | PR12A | 2 | RDQ10 | T (LVDS)* | PR12A | 2 | RDQ10 | T (LVDS)* |
| G14 | PR10B | 2 | RDQ10 | C (LVDS)* | PR10B | 2 | RDQ10 | C (LVDS)* |
| G13 | PR10A | 2 | RDQS10 | T (LVDS)* | PR10A | 2 | RDQS10 | T (LVDS)* |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| F16 | PR8B | 2 | RDQ10 | C (LVDS)* | PR8B | 2 | RDQ10 | C (LVDS)* |
| F9 | PR9B | 2 | RDQ10 | C | PR9B | 2 | RDQ10 | C |
| E16 | PR8A | 2 | RDQ10 | T (LVDS)* | PR8A | 2 | RDQ10 | T (LVDS)* |
| F10 | PR9A | 2 | RDQ10 | T | PR9A | 2 | RDQ10 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| D16 | PR7B | 2 | RDQ10 | C | PR7B | 2 | RDQ10 | C |
| D15 | PR7A | 2 | RDQ10 | T | PR7A | 2 | RDQ10 | T |
| C15 | PR4B | 2 | | C (LVDS)* | PR4B | 2 | | C (LVDS)* |
| C16 | PR5B | 2 | | C | PR5B | 2 | | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| D14 | PR4A | 2 | | T (LVDS)* | PR4A | 2 | | T (LVDS)* |
| B16 | PR5A | 2 | | T | PR5A | 2 | | T |
| F13 | PR2B | 2 | VREF2_2 | C (LVDS)* | PR2B | 2 | VREF2_2 | C (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| E13 | PR2A | 2 | VREF1_2 | T (LVDS)* | PR2A | 2 | VREF1_2 | T (LVDS)* |
| F11 | PT28B | 1 | VREF2_1 | C | PT55B | 1 | VREF2_1 | C |
| E11 | PT28A | 1 | VREF1_1 | T | PT55A | 1 | VREF1_1 | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| A15 | PT27B | 1 | | C | PT54B | 1 | | C |
| E12 | PT26B | 1 | | C | PT53B | 1 | | C |
| B15 | PT27A | 1 | | T | PT54A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D12 | PT26A | 1 | | T | PT53A | 1 | | T |
| B14 | PT25B | 1 | | C | PT52B | 1 | | C |
| C14 | PT24B | 1 | | C | PT51B | 1 | | C |
| A14 | PT25A | 1 | | T | PT52A | 1 | | T |
| D13 | PT24A | 1 | | T | PT51A | 1 | | T |
| C13 | PT23B | 1 | | C | PT50B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| A13 | PT22B | 1 | | C | PT49B | 1 | | C |
| B13 | PT23A | 1 | | T | PT50A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A12 | PT22A | 1 | | T | PT49A | 1 | | T |
| B11 | PT21B | 1 | | C | PT48B | 1 | | C |
| D11 | PT20B | 1 | | C | PT47B | 1 | | C |
| A11 | PT21A | 1 | | T | PT48A | 1 | | T |
| C11 | PT20A | 1 | | T | PT47A | 1 | | T |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| - | - | - | | | GNDIO1 | 1 | | |
| - | - | - | | | VCCIO | 1 | | |
| D10 | PT19B | 1 | | C | PT37B | 1 | | C |
| C10 | PT19A | 1 | | T | PT37A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| B10 | PT18B | 1 | | C | PT36B | 1 | | C |
| A9 | PT17B | 1 | | C | PT35B | 1 | | C |
| A10 | PT18A | 1 | | T | PT36A | 1 | | T |
| B9 | PT17A | 1 | | T | PT35A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A8 | PT16B | 1 | | C | PT34B | 1 | | C |
| D9 | PT15B | 1 | | C | PT33B | 1 | | C |
| B8 | PT16A | 1 | | T | PT34A | 1 | | T |
| C9 | PT15A | 1 | | T | PT33A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| B7 | PT14B | 1 | | C | PT32B | 1 | | C |
| E9 | PT13B | 1 | | C | PT31B | 1 | | C |
| A7 | PT14A | 1 | | T | PT32A | 1 | | T |
| D8 | PT13A | 1 | | T | PT31A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A6 | PT12B | 1 | PCLKC1_0 | C | PT30B | 1 | PCLKC1_0 | C |
| B6 | PT12A | 1 | PCLKT1_0 | T | PT30A | 1 | PCLKT1_0 | T |
| E6 | XRES | - | | | XRES | 1 | | |
| F8 | PT10B | 0 | PCLKC0_0 | C | PT28B | 0 | PCLKC0_0 | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| E8 | PT10A | 0 | PCLKT0_0 | T | PT28A | 0 | PCLKT0_0 | T |
| A5 | PT9B | 0 | | C | PT27B | 0 | | C |
| A3 | PT8B | 0 | | C | PT26B | 0 | | C |
| A4 | PT9A | 0 | | T | PT27A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| B3 | PT8A | 0 | | T | PT26A | 0 | | T |
| A2 | PT7B | 0 | | C | PT25B | 0 | | C |
| C7 | PT6B | 0 | | C | PT24B | 0 | | C |
| B2 | PT7A | 0 | | T | PT25A | 0 | | T |
| D7 | PT6A | 0 | | T | PT24A | 0 | | T |
| D6 | PT5B | 0 | | C | PT23B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| F7 | PT4B | 0 | | C | PT22B | 0 | | C |
| C6 | PT5A | 0 | | T | PT23A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F6 | PT4A | 0 | | T | PT22A | 0 | | T |
| C4 | PT3B | 0 | | C | PT21B | 0 | | C |
| B4 | PT3A | 0 | | T | PT21A | 0 | | T |
| - | - | - | | | GNDIO0 | 0 | | |
| - | - | - | | | VCCIO | 0 | | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D5 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| E5 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |
| G7 | VCC | - | | | VCC | - | | |
| G9 | VCC | - | | | VCC | - | | |
| H7 | VCC | - | | | VCC | - | | |
| J10 | VCC | - | | | VCC | - | | |
| K10 | VCC | - | | | VCC | - | | |
| K8 | VCC | - | | | VCC | - | | |
| G8 | VCCAUX | - | | | VCCAUX | - | | |
| H10 | VCCAUX | - | | | VCCAUX | - | | |
| J7 | VCCAUX | - | | | VCCAUX | - | | |
| K9 | VCCAUX | - | | | VCCAUX | - | | |
| C5 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E7 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C12 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E10 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E14 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| G12 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K12 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| M14 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| M10 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| P12 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| M7 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| P5 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| K5 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| M3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| E3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| G5 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| T15 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| A1 | GND | - | | | GND | - | | |
| A16 | GND | - | | | GND | - | | |
| B12 | GND | - | | | GND | - | | |
| B5 | GND | - | | | GND | - | | |
| C8 | GND | - | | | GND | - | | |
| E15 | GND | - | | | GND | - | | |
| E2 | GND | - | | | GND | - | | |
| H14 | GND | - | | | GND | - | | |
| H8 | GND | - | | | GND | - | | |
| H9 | GND | - | | | GND | - | | |
| J3 | GND | - | | | GND | - | | |
| J8 | GND | - | | | GND | - | | |
| J9 | GND | - | | | GND | - | | |
| M15 | GND | - | | | GND | - | | |
| M2 | GND | - | | | GND | - | | |
| P9 | GND | - | | | GND | - | | |

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-6E/SE | | | | | LFE2-12E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| R12 | GND | - | | | GND | - | | |
| R5 | GND | - | | | GND | - | | |
| T1 | GND | - | | | GND | - | | |
| T16 | GND | - | | | GND | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE Logic Signal Connections: 256 fpBGA

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| C3 | C3 | PL2A | 7 | VREF2_7 | T (LVDS)* |
| C2 | C2 | PL2B | 7 | VREF1_7 | C (LVDS)* |
| VCCIO | VCCIO | VCCIO7 | 7 | | |
| - | GND | GNDIO7 | 7 | | |
| D3 | D3 | PL7A | 7 | LDQ8 | T |
| D4 | D4 | PL6A | 7 | LDQ8 | T (LVDS)* |
| D2 | D2 | PL7B | 7 | LDQ8 | C |
| GND | GND | GNDIO7 | - | | |
| E4 | E4 | PL6B | 7 | LDQ8 | C (LVDS)* |
| B1 | B1 | PL13A | 7 | LDQ16 | T |
| C1 | C1 | PL13B | 7 | LDQ16 | C |
| F5 | F5 | PL15A | 7 | LDQ16 | T |
| VCCIO | VCC | VCCIO | 7 | | |
| F4 | F4 | PL14A | 7 | LDQ16 | T (LVDS)* |
| G6 | G6 | PL15B | 7 | LDQ16 | C |
| G4 | G4 | PL14B | 7 | LDQ16 | C (LVDS)* |
| D1 | D1 | PL16A | 7 | LDQS16 | T (LVDS)* |
| GND | GND | GNDIO7 | - | | |
| E1 | E1 | PL16B | 7 | LDQ16 | C (LVDS)* |
| F3 | F3 | PL17A | 7 | LDQ16 | T |
| G3 | G3 | PL17B | 7 | LDQ16 | C |
| VCCIO | VCCIO | VCCIO7 | 7 | | |
| F2 | F2 | PL18A | 7 | LDQ16 | T (LVDS)* |
| F1 | F1 | PL18B | 7 | LDQ16 | C (LVDS)* |
| GND | GND | GNDIO7 | - | | |
| G2 | G2 | PL19A | 7 | PCLKT7_0/LDQ16 | T |
| G1 | G1 | PL19B | 7 | PCLKC7_0/LDQ16 | C |
| H6 | H6 | PL21A | 6 | PCLKT6_0/LDQ25 | T (LVDS)* |
| VCCIO | VCCIO | VCCIO6 | 6 | | |
| H5 | H5 | PL21B | 6 | PCLKC6_0/LDQ25 | C (LVDS)* |
| H4 | H4 | PL22A | 6 | VREF2_6/LDQ25 | T |
| GND | GND | GNDIO6 | - | | |
| H3 | H3 | PL22B | 6 | VREF1_6/LDQ25 | C |
| H2 | H2 | PL27A | 6 | LLM0_GDLLT_IN_A**/LDQ25 | T (LVDS)* |
| H1 | H1 | PL27B | 6 | LLM0_GDLLC_IN_A**/LDQ25 | C (LVDS)* |
| G10 | G10 | VCC | - | | |
| J4 | J4 | PL28A | 6 | LLM0_GDLLT_FB_A/LDQ25 | T |
| J5 | J5 | PL28B | 6 | LLM0_GDLLC_FB_A/LDQ25 | C |
| J6 | J6 | LLM0_PLLCAP | 6 | | |
| K4 | K4 | PL30A | 6 | LLM0_GPLLT_IN_A**/LDQ34 | T (LVDS)* |
| GND | GND | GNDIO6 | - | | |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| J1 | J1 | PL31A | 6 | LLM0_GPLLT_FB_A/LDQ34 | T |
| K3 | K3 | PL30B | 6 | LLM0_GPLLC_IN_A**/LDQ34 | C (LVDS)* |
| VCCIO | VCCIO | VCCIO6 | 6 | | |
| J2 | J2 | PL31B | 6 | LLM0_GPLLC_FB_A/LDQ34 | C |
| GND | GND | GNDIO6 | - | | |
| L2 | L2 | PL38A | 6 | LDQ42 | T (LVDS)* |
| K2 | K2 | PL39A | 6 | LDQ42 | T |
| L3 | L3 | PL38B | 6 | LDQ42 | C (LVDS)* |
| K1 | K1 | PL39B | 6 | LDQ42 | C |
| VCCIO | VCCIO | VCCIO6 | 6 | | |
| L4 | L4 | PL40A | 6 | LDQ42 | T (LVDS)* |
| L1 | L1 | PL41A | 6 | LDQ42 | T |
| L5 | L5 | PL40B | 6 | LDQ42 | C (LVDS)* |
| M1 | M1 | PL41B | 6 | LDQ42 | C |
| GND | GND | GNDIO6 | - | | |
| N1 | N1 | PL43A | 6 | LDQ42 | T |
| N2 | N2 | PL42A | 6 | LDQS42 | T (LVDS)* |
| P1 | P1 | PL43B | 6 | LDQ42 | C |
| VCCIO | VCCIO | VCCIO6 | 6 | | |
| P2 | P2 | PL42B | 6 | LDQ42 | C (LVDS)* |
| R1 | R1 | PL44A | 6 | LDQ42 | T (LVDS)* |
| GND | GND | GNDIO6 | - | | |
| R2 | R2 | PL44B | 6 | LDQ42 | C (LVDS)* |
| N4 | N4 | TDI | - | | |
| M4 | M4 | TCK | - | | |
| P3 | P3 | TDO | - | | |
| N3 | N3 | TMS | - | | |
| K7 | K7 | VCCJ | - | | |
| M5 | M5 | PB2A | 5 | VREF2_5/BDQ6 | T |
| K6 | K6 | PB3A | 5 | BDQ6 | |
| M6 | M6 | PB2B | 5 | VREF1_5/BDQ6 | C |
| R3 | R3 | PB5A | 5 | BDQ6 | T |
| P4 | P4 | PB5B | 5 | BDQ6 | C |
| - | VCC | VCCIO | 5 | | |
| - | GND | GNDIO5 | 5 | | |
| N5 | N5 | PB30A | 5 | BDQ33 | T |
| N6 | N6 | PB30B | 5 | BDQ33 | C |
| T2 | T2 | PB31A | 5 | BDQ33 | T |
| P6 | P6 | PB32A | 5 | BDQ33 | T |
| VCCIO | VCCIO | VCCIO5 | 5 | | |
| T3 | T3 | PB31B | 5 | BDQ33 | C |
| R6 | R6 | PB32B | 5 | BDQ33 | C |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|----------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| GND | GND | GNDIO5 | - | | |
| R4 | R4 | PB33A | 5 | BDQS33 | T |
| L6 | L6 | PB34A | 5 | BDQ33 | T |
| T4 | T4 | PB33B | 5 | BDQ33 | C |
| L7 | L7 | PB34B | 5 | BDQ33 | C |
| N7 | N7 | PB35A | 5 | PCLKT5_0/BDQ33 | T |
| VCCIO | VCCIO | VCCIO5 | 5 | | |
| M8 | M8 | PB35B | 5 | PCLKC5_0/BDQ33 | C |
| GND | GND | GNDIO5 | - | | |
| P7 | P7 | PB40A | 4 | PCLKT4_0/BDQ42 | T |
| R8 | R8 | PB40B | 4 | PCLKC4_0/BDQ42 | C |
| VCCIO | VCCIO | VCCIO4 | 4 | | |
| T5 | T5 | PB41A | 4 | BDQ42 | T |
| T6 | T6 | PB41B | 4 | BDQ42 | C |
| T8 | T8 | PB42A | 4 | BDQS42 | T |
| GND | GND | GNDIO4 | - | | |
| R7 | R7 | PB43A | 4 | BDQ42 | T |
| T9 | T9 | PB42B | 4 | BDQ42 | C |
| T7 | T7 | PB43B | 4 | BDQ42 | C |
| L8 | L8 | PB44A | 4 | BDQ42 | T |
| VCCIO | VCCIO | VCCIO4 | 4 | | |
| P8 | P8 | PB45A | 4 | BDQ42 | T |
| L9 | L9 | PB44B | 4 | BDQ42 | C |
| N8 | N8 | PB45B | 4 | BDQ42 | C |
| R9 | R9 | PB46A | 4 | BDQ42 | T |
| GND | GND | GNDIO4 | - | | |
| R10 | R10 | PB46B | 4 | BDQ42 | C |
| - | VCC | VCCIO | 4 | | |
| - | GND | GNDIO4 | 4 | | |
| N9 | N9 | PB56A | 4 | BDQ60 | T |
| T10 | T10 | PB57A | 4 | BDQ60 | T |
| M9 | M9 | PB56B | 4 | BDQ60 | C |
| R11 | R11 | PB57B | 4 | BDQ60 | C |
| P10 | P10 | PB58A | 4 | BDQ60 | T |
| N11 | N11 | PB59A | 4 | BDQ60 | T |
| VCCIO | VCCIO | VCCIO4 | 4 | | |
| N10 | N10 | PB58B | 4 | BDQ60 | C |
| P11 | P11 | PB59B | 4 | BDQ60 | C |
| T11 | T11 | PB60A | 4 | BDQS60 | T |
| GND | GND | GNDIO4 | - | | |
| M11 | M11 | PB61A | 4 | BDQ60 | T |
| T12 | T12 | PB60B | 4 | BDQ60 | C |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|--------------------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| L11 | L11 | PB61B | 4 | BDQ60 | C |
| T13 | T13 | PB62A | 4 | BDQ60 | T |
| R13 | R13 | PB63A | 4 | BDQ60 | T |
| VCCIO | VCCIO | VCCIO4 | 4 | | |
| T14 | T14 | PB62B | 4 | BDQ60 | C |
| P13 | P13 | PB63B | 4 | BDQ60 | C |
| GND | GND | GNDIO4 | - | | |
| N12 | N12 | PB64A | 4 | VREF2_4/BDQ60 | T |
| M12 | M12 | PB64B | 4 | VREF1_4/BDQ60 | C |
| R15 | R15 | CFG2 | 8 | | |
| N14 | N14 | CFG1 | 8 | | |
| N13 | N13 | PROGRAMN | 8 | | |
| N15 | N15 | CFG0 | 8 | | |
| P15 | P15 | PR44B | 8 | WRITEN | C |
| L12 | L12 | INITN | 8 | | |
| N16 | N16 | PR43B | 8 | CSN | C |
| GND | GND | GNDIO8 | - | | |
| R14 | R14 | CCLK | 8 | | |
| P14 | P14 | PR44A | 8 | CS1N | T |
| M13 | M13 | DONE | 8 | | |
| R16 | R16 | PR42B | 8 | D1 | C |
| VCCIO | VCCIO | VCCIO8 | 8 | | |
| M16 | M16 | PR43A | 8 | D0/SPIFASTN | T |
| P16 | P16 | PR42A | 8 | D2 | T |
| L15 | L15 | PR41B | 8 | D3 | C |
| GND | GND | GNDIO8 | - | | |
| L14 | L14 | PR40A | 8 | D6 | T |
| L16 | L16 | PR41A | 8 | D4 | T |
| L10 | L10 | PR39B | 8 | D7/SPID0 | C |
| L13 | L13 | PR40B | 8 | D5 | C |
| VCCIO | VCCIO | VCCIO8 | 8 | | |
| K11 | K11 | PR39A | 8 | DI/CSSPI0N | T |
| K14 | K14 | PR38B | 8 | DOUT/CSON | C |
| K13 | K13 | PR38A | 8 | BUSY/SISPI | T |
| GND | GND | GNDIO8 | - | | |
| K15 | K15 | PR31B | 3 | RLM0_GPLL_C_FB_A/RDQ34 | C |
| VCCIO | VCCIO | VCCIO3 | 3 | | |
| K16 | K16 | PR31A | 3 | RLM0_GPLLT_FB_A/RDQ34 | T |
| GND | GND | GNDIO3 | - | | |
| J16 | J16 | PR30B | 3 | RLM0_GPLL_C_IN_A**/RDQ34 | C (LVDS)* |
| J15 | J15 | PR30A | 3 | RLM0_GPLLT_IN_A**/RDQ34 | T (LVDS)* |
| J14 | J14 | RLM0_PLLCAP | 3 | | |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| J13 | J13 | PR28B | 3 | RLM0_GDLLC_FB_A/RDQ25 | C |
| J12 | J12 | PR28A | 3 | RLM0_GDLLT_FB_A/RDQ25 | T |
| H12 | H12 | PR27B | 3 | RLM0_GDLLC_IN_A**/RDQ25 | C (LVDS)* |
| GND | GND | GNDIO3 | - | | |
| H13 | H13 | PR27A | 3 | RLM0_GDLLT_IN_A**/RDQ25 | T (LVDS)* |
| H15 | H15 | PR22B | 3 | VREF2_3/RDQ25 | C |
| VCCIO | VCCIO | VCCIO3 | 3 | | |
| H16 | H16 | PR22A | 3 | VREF1_3/RDQ25 | T |
| H11 | H11 | PR21B | 3 | PCLKC3_0/RDQ25 | C (LVDS)* |
| J11 | J11 | PR21A | 3 | PCLKT3_0/RDQ25 | T (LVDS)* |
| G16 | G16 | PR19B | 2 | PCLKC2_0/RDQ16 | C |
| GND | GND | GNDIO2 | - | | |
| G15 | G15 | PR19A | 2 | PCLKT2_0/RDQ16 | T |
| F15 | F15 | PR17B | 2 | RDQ16 | C |
| G11 | G11 | PR18B | 2 | RDQ16 | C (LVDS)* |
| F14 | F14 | PR17A | 2 | RDQ16 | T |
| VCCIO | VCCIO | VCCIO2 | 2 | | |
| F12 | F12 | PR18A | 2 | RDQ16 | T (LVDS)* |
| G14 | G14 | PR16B | 2 | RDQ16 | C (LVDS)* |
| G13 | G13 | PR16A | 2 | RDQS16 | T (LVDS)* |
| GND | GND | GNDIO2 | - | | |
| F16 | F16 | PR14B | 2 | RDQ16 | C (LVDS)* |
| F9 | F9 | PR15B | 2 | RDQ16 | C |
| E16 | E16 | PR14A | 2 | RDQ16 | T (LVDS)* |
| F10 | F10 | PR15A | 2 | RDQ16 | T |
| VCCIO | VCCIO | VCCIO2 | 2 | | |
| D16 | D16 | PR13B | 2 | RDQ16 | C |
| D15 | D15 | PR13A | 2 | RDQ16 | T |
| C15 | C15 | PR6B | 2 | RDQ8 | C (LVDS)* |
| C16 | C16 | PR7B | 2 | RDQ8 | C |
| GND | GND | GNDIO2 | - | | |
| D14 | D14 | PR6A | 2 | RDQ8 | T (LVDS)* |
| B16 | B16 | PR7A | 2 | RDQ8 | T |
| F13 | F13 | PR2B | 2 | VREF2_2 | C (LVDS)* |
| VCCIO | VCCIO | VCCIO2 | 2 | | |
| E13 | E13 | PR2A | 2 | VREF1_2 | T (LVDS)* |
| F11 | F11 | PT64B | 1 | VREF2_1 | C |
| E11 | E11 | PT64A | 1 | VREF1_1 | T |
| GND | GND | GNDIO1 | - | | |
| A15 | A15 | PT63B | 1 | | C |
| E12 | E12 | PT62B | 1 | | C |
| B15 | B15 | PT63A | 1 | | T |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO | VCCIO1 | 1 | | |
| D12 | D12 | PT62A | 1 | | T |
| B14 | B14 | PT61B | 1 | | C |
| C14 | C14 | PT60B | 1 | | C |
| A14 | A14 | PT61A | 1 | | T |
| D13 | D13 | PT60A | 1 | | T |
| C13 | C13 | PT59B | 1 | | C |
| GND | GND | GNDIO1 | - | | |
| A13 | A13 | PT58B | 1 | | C |
| B13 | B13 | PT59A | 1 | | T |
| VCCIO | VCCIO | VCCIO1 | 1 | | |
| A12 | A12 | PT58A | 1 | | T |
| B11 | B11 | PT57B | 1 | | C |
| D11 | D11 | PT56B | 1 | | C |
| A11 | A11 | PT57A | 1 | | T |
| C11 | C11 | PT56A | 1 | | T |
| - | GND | GNDIO1 | 1 | | |
| - | VCC | VCCIO | 1 | | |
| D10 | D10 | PT46B | 1 | | C |
| C10 | C10 | PT46A | 1 | | T |
| GND | GND | GNDIO1 | - | | |
| B10 | B10 | PT45B | 1 | | C |
| A9 | A9 | PT44B | 1 | | C |
| A10 | A10 | PT45A | 1 | | T |
| B9 | B9 | PT44A | 1 | | T |
| VCCIO | VCCIO | VCCIO1 | 1 | | |
| A8 | A8 | PT43B | 1 | | C |
| D9 | D9 | PT42B | 1 | | C |
| B8 | B8 | PT43A | 1 | | T |
| C9 | C9 | PT42A | 1 | | T |
| GND | GND | GNDIO1 | - | | |
| B7 | B7 | PT41B | 1 | | C |
| E9 | E9 | PT40B | 1 | | C |
| A7 | A7 | PT41A | 1 | | T |
| D8 | D8 | PT40A | 1 | | T |
| VCCIO | VCCIO | VCCIO1 | 1 | | |
| A6 | A6 | PT39B | 1 | PCLKC1_0 | C |
| B6 | B6 | PT39A | 1 | PCLKT1_0 | T |
| E6 | E6 | XRES | 1 | | |
| F8 | F8 | PT37B | 0 | PCLKC0_0 | C |
| GND | GND | GNDIO0 | - | | |
| E8 | E8 | PT37A | 0 | PCLKT0_0 | T |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| A5 | A5 | PT36B | 0 | | C |
| A3 | A3 | PT35B | 0 | | C |
| A4 | A4 | PT36A | 0 | | T |
| VCCIO | VCCIO | VCCIO0 | 0 | | |
| B3 | B3 | PT35A | 0 | | T |
| A2 | A2 | PT34B | 0 | | C |
| C7 | C7 | PT33B | 0 | | C |
| B2 | B2 | PT34A | 0 | | T |
| D7 | D7 | PT33A | 0 | | T |
| D6 | D6 | PT32B | 0 | | C |
| GND | GND | GNDIO0 | - | | |
| F7 | F7 | PT31B | 0 | | C |
| C6 | C6 | PT32A | 0 | | T |
| VCCIO | VCCIO | VCCIO0 | 0 | | |
| F6 | F6 | PT31A | 0 | | T |
| C4 | C4 | PT30B | 0 | | C |
| B4 | B4 | PT30A | 0 | | T |
| - | GND | GNDIO0 | 0 | | |
| - | VCC | VCCIO | 0 | | |
| D5 | D5 | PT2B | 0 | VREF2_0 | C |
| E5 | E5 | PT2A | 0 | VREF1_0 | T |
| G7 | G7 | VCC | - | | |
| G9 | G9 | VCC | - | | |
| H7 | H7 | VCC | - | | |
| J10 | J10 | VCC | - | | |
| K10 | K10 | VCC | - | | |
| K8 | K8 | VCC | - | | |
| G8 | G8 | VCCAUX | - | | |
| H10 | H10 | VCCAUX | - | | |
| J7 | J7 | VCCAUX | - | | |
| K9 | K9 | VCCAUX | - | | |
| C5 | C5 | VCCIO0 | 0 | | |
| E7 | E7 | VCCIO0 | 0 | | |
| C12 | C12 | VCCIO1 | 1 | | |
| E10 | E10 | VCCIO1 | 1 | | |
| E14 | E14 | VCCIO2 | 2 | | |
| G12 | G12 | VCCIO2 | 2 | | |
| K12 | K12 | VCCIO3 | 3 | | |
| M14 | M14 | VCCIO3 | 3 | | |
| M10 | M10 | VCCIO4 | 4 | | |
| P12 | P12 | VCCIO4 | 4 | | |
| M7 | M7 | VCCIO5 | 5 | | |

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

| LFE2-20E/SE | | | | | |
|-------------|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| P5 | P5 | VCCIO5 | 5 | | |
| K5 | K5 | VCCIO6 | 6 | | |
| M3 | M3 | VCCIO6 | 6 | | |
| E3 | E3 | VCCIO7 | 7 | | |
| G5 | G5 | VCCIO7 | 7 | | |
| T15 | T15 | VCCIO8 | 8 | | |
| A1 | A1 | GND | - | | |
| A16 | A16 | GND | - | | |
| B12 | B12 | GND | - | | |
| B5 | B5 | GND | - | | |
| C8 | C8 | GND | - | | |
| E15 | E15 | GND | - | | |
| E2 | E2 | GND | - | | |
| H14 | H14 | GND | - | | |
| H8 | H8 | GND | - | | |
| H9 | H9 | GND | - | | |
| J3 | J3 | GND | - | | |
| J8 | J8 | GND | - | | |
| J9 | J9 | GND | - | | |
| M15 | M15 | GND | - | | |
| M2 | M2 | GND | - | | |
| P9 | P9 | GND | - | | |
| R12 | R12 | GND | - | | |
| R5 | R5 | GND | - | | |
| T1 | T1 | GND | - | | |
| T16 | T16 | GND | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E4 | PL2A | 7 | VREF2_7 | T (LVDS)* | PL2A | 7 | VREF2_7 | T (LVDS)* |
| E5 | PL2B | 7 | VREF1_7 | C (LVDS)* | PL2B | 7 | VREF1_7 | C (LVDS)* |
| - | - | - | | | GNDIO7 | - | | |
| E3 | NC | - | | | PL4A | 7 | LDQ8 | T (LVDS)* |
| F4 | PL3A | 7 | | T | PL5A | 7 | LDQ8 | T |
| F3 | NC | - | | | PL4B | 7 | LDQ8 | C (LVDS)* |
| F5 | PL3B | 7 | | C | PL5B | 7 | LDQ8 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| E2 | PL4A | 7 | | T (LVDS)* | PL6A | 7 | LDQ8 | T (LVDS)* |
| G6 | PL5A | 7 | | T | PL7A | 7 | LDQ8 | T |
| E1 | PL4B | 7 | | C (LVDS)* | PL6B | 7 | LDQ8 | C (LVDS)* |
| G7 | PL5B | 7 | | C | PL7B | 7 | LDQ8 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| F1 | NC | - | | | PL9A | 7 | LDQ8 | T |
| H4 | NC | - | | | PL8A | 7 | LDQS8 | T (LVDS)* |
| F2 | NC | - | | | PL9B | 7 | LDQ8 | C |
| - | - | - | | | VCCIO7 | 7 | | |
| H5 | NC | - | | | PL8B | 7 | LDQ8 | C (LVDS)* |
| G1 | NC | - | | | PL11A | 7 | LDQ8 | T |
| G3 | NC | - | | | PL10A | 7 | LDQ8 | T (LVDS)* |
| G2 | NC | - | | | PL11B | 7 | LDQ8 | C |
| - | - | - | | | GNDIO | - | | |
| G4 | NC | - | | | PL10B | 7 | LDQ8 | C (LVDS)* |
| J4 | PL7A | 7 | LDQ10 | T | PL13A | 7 | LDQ16 | T |
| H1 | PL6A | 7 | LDQ10 | | PL12A | 7 | LDQ16 | T (LVDS)* |
| J5 | PL7B | 7 | LDQ10 | C | PL13B | 7 | LDQ16 | C |
| L6 | PL9A | 7 | LDQ10 | T | PL15A | 7 | LDQ16 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J2 | PL8A | 7 | LDQ10 | T (LVDS)* | PL14A | 7 | LDQ16 | T (LVDS)* |
| L5 | PL9B | 7 | LDQ10 | C | PL15B | 7 | LDQ16 | C |
| J1 | PL8B | 7 | LDQ10 | C (LVDS)* | PL14B | 7 | LDQ16 | C (LVDS)* |
| K3 | PL10A | 7 | LDQS10 | T (LVDS)* | PL16A | 7 | LDQS16 | T (LVDS)* |
| GNDIO | GNDIO7 | - | | | GNDIO | - | | |
| K4 | PL10B | 7 | LDQ10 | C (LVDS)* | PL16B | 7 | LDQ16 | C (LVDS)* |
| K2 | PL11A | 7 | LDQ10 | T | PL17A | 7 | LDQ16 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K1 | PL11B | 7 | LDQ10 | C | PL17B | 7 | LDQ16 | C |
| L4 | PL12A | 7 | LDQ10 | T (LVDS)* | PL18A | 7 | LDQ16 | T (LVDS)* |
| GNDIO | GNDIO7 | - | | | GNDIO | - | | |
| L3 | PL12B | 7 | LDQ10 | C (LVDS)* | PL18B | 7 | LDQ16 | C (LVDS)* |
| L2 | PL13A | 7 | PCLKT7_0/LDQ10 | T | PL19A | 7 | PCLKT7_0/LDQ16 | T |
| L1 | PL13B | 7 | PCLKC7_0/LDQ10 | C | PL19B | 7 | PCLKC7_0/LDQ16 | C |
| M5 | PL15A | 6 | PCLKT6_0 | T (LVDS)* | PL21A | 6 | PCLKT6_0/LDQ25 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | - | - | | |
| M6 | PL15B | 6 | PCLKC6_0 | C (LVDS)* | PL21B | 6 | PCLKC6_0/LDQ25 | C (LVDS)* |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|-------------------|--------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| M3 | PL16A | 6 | VREF2_6 | T | PL22A | 6 | VREF2_6/LDQ25 | T |
| GNDIO | GNDIO6 | - | | | - | - | | |
| M4 | PL16B | 6 | VREF1_6 | C | PL22B | 6 | VREF1_6/LDQ25 | C |
| - | - | - | | | VCCIO6 | 6 | | |
| N1 | NC | - | | | PL24A | 6 | LDQ25 | T |
| M2 | NC | - | | | PL23A | 6 | LDQ25 | T (LVDS)* |
| N2 | NC | - | | | PL24B | 6 | LDQ25 | C |
| M1 | NC | - | | | PL23B | 6 | LDQ25 | C (LVDS)* |
| - | - | - | | | GNDIO | - | | |
| N3 | NC | - | | | PL25A | 6 | LDQS25 | T (LVDS)* |
| N5 | NC | - | | | PL26A | 6 | LDQ25 | T |
| N4 | NC | - | | | PL25B | 6 | LDQ25 | C (LVDS)* |
| - | - | - | | | VCCIO6 | 6 | | |
| P5 | NC | - | | | PL26B | 6 | LDQ25 | C |
| P1 | PL17A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* | PL27A | 6 | LLM0_GDLLT_IN_A**/LDQ25 | T (LVDS)* |
| P2 | PL17B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* | PL27B | 6 | LLM0_GDLLC_IN_A**/LDQ25 | C (LVDS)* |
| P4 | PL18A | 6 | LLM0_GDLLT_FB_A | T | PL28A | 6 | LLM0_GDLLT_FB_A/LDQ25 | T |
| - | - | - | | | GNDIO | - | | |
| R4 | PL18B | 6 | LLM0_GDLLC_FB_A | C | PL28B | 6 | LLM0_GDLLC_FB_A/LDQ25 | C |
| P6 | LLM0_PLCCAP | 6 | | | LLM0_PLCCAP | 6 | | |
| R1 | PL20A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | PL30A | 6 | LLM0_GPLLT_IN_A**/LDQ34 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | - | - | | |
| R3 | PL21A | 6 | LLM0_GPLLT_FB_A | T | PL31A | 6 | LLM0_GPLLT_FB_A/LDQ34 | T |
| R2 | PL20B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | PL30B | 6 | LLM0_GPLLC_IN_A**/LDQ34 | C (LVDS)* |
| T4 | PL21B | 6 | LLM0_GPLLC_FB_A | C | PL31B | 6 | LLM0_GPLLC_FB_A/LDQ34 | C |
| T5 | PL23A | 6 | | T | PL33A | 6 | LDQ34 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| T1 | PL22A | 6 | | T (LVDS)* | PL32A | 6 | LDQ34 | T (LVDS)* |
| T3 | PL23B | 6 | | C | PL33B | 6 | LDQ34 | C |
| T2 | PL22B | 6 | | C (LVDS)* | PL32B | 6 | LDQ34 | C (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| - | - | - | | | VCCIO6 | 6 | | |
| V1 | PL25A | 6 | LDQ28 | T | PL39A | 6 | LDQ42 | T |
| - | - | - | | | GNDIO | - | | |
| V2 | PL25B | 6 | LDQ28 | C | PL39B | 6 | LDQ42 | C |
| U1 | PL24A | 6 | LDQ28 | T (LVDS)* | PL38A | 6 | LDQ42 | T (LVDS)* |
| U3 | PL27A | 6 | LDQ28 | T | PL41A | 6 | LDQ42 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| U2 | PL24B | 6 | LDQ28 | C (LVDS)* | PL38B | 6 | LDQ42 | C (LVDS)* |
| U4 | PL27B | 6 | LDQ28 | C | PL41B | 6 | LDQ42 | C |
| R6 | PL26A | 6 | LDQ28 | T (LVDS)* | PL40A | 6 | LDQ42 | T (LVDS)* |
| R7 | PL29A | 6 | LDQ28 | T | PL43A | 6 | LDQ42 | T |
| GNDIO | GNDIO6 | - | | | GNDIO | - | | |
| T7 | PL29B | 6 | LDQ28 | C | PL43B | 6 | LDQ42 | C |
| T6 | PL26B | 6 | LDQ28 | C (LVDS)* | PL40B | 6 | LDQ42 | C (LVDS)* |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AA2 | PL31A | 6 | LDQ28 | T | PL45A | 6 | LDQ42 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y1 | PL28A | 6 | LDQS28 | T (LVDS)* | PL42A | 6 | LDQS42 | T (LVDS)* |
| AA1 | PL31B | 6 | LDQ28 | C | PL45B | 6 | LDQ42 | C |
| W1 | PL28B | 6 | LDQ28 | C (LVDS)* | PL42B | 6 | LDQ42 | C (LVDS)* |
| V3 | PL30B | 6 | LDQ28 | C (LVDS)* | PL44B | 6 | LDQ42 | C (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO | - | | |
| V4 | PL30A | 6 | LDQ28 | T (LVDS)* | PL44A | 6 | LDQ42 | T (LVDS)* |
| U5 | TDI | - | | | TDI | - | | |
| U7 | TCK | - | | | TCK | - | | |
| V6 | TDO | - | | | TDO | - | | |
| V5 | TMS | - | | | TMS | - | | |
| T8 | VCCJ | - | | | VCCJ | - | | |
| W4 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T |
| Y3 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T |
| W3 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C |
| Y2 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C |
| AB3 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| W5 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T |
| AB2 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C |
| W6 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C |
| AB5 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T |
| GNDIO | GNDIO5 | - | | | GNDIO | - | | |
| Y4 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T |
| AB4 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C |
| AA3 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C |
| AB6 | PB9A | 5 | BDQ6 | T | PB9A | 5 | BDQ6 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA5 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T |
| AA6 | PB9B | 5 | BDQ6 | C | PB9B | 5 | BDQ6 | C |
| Y5 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C |
| GNDIO | GNDIO5 | - | | | GNDIO | - | | |
| - | - | - | | | VCCIO5 | 5 | | |
| Y6 | PB12A | 5 | BDQ15 | T | PB21A | 5 | BDQ24 | T |
| W7 | PB11A | 5 | BDQ15 | T | PB20A | 5 | BDQ24 | T |
| Y7 | PB12B | 5 | BDQ15 | C | PB21B | 5 | BDQ24 | C |
| W8 | PB11B | 5 | BDQ15 | C | PB20B | 5 | BDQ24 | C |
| U8 | PB14A | 5 | BDQ15 | T | PB23A | 5 | BDQ24 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA7 | PB13A | 5 | BDQ15 | T | PB22A | 5 | BDQ24 | T |
| U9 | PB14B | 5 | BDQ15 | C | PB23B | 5 | BDQ24 | C |
| AB7 | PB13B | 5 | BDQ15 | C | PB22B | 5 | BDQ24 | C |
| Y8 | PB16A | 5 | BDQ15 | T | PB25A | 5 | BDQ24 | T |
| GNDIO | GNDIO5 | - | | | GNDIO | - | | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| W9 | PB15A | 5 | BDQS15 | T | PB24A | 5 | BDQS24 | T |
| AA8 | PB16B | 5 | BDQ15 | C | PB25B | 5 | BDQ24 | C |
| V9 | PB15B | 5 | BDQ15 | C | PB24B | 5 | BDQ24 | C |
| AB8 | PB18A | 5 | BDQ15 | T | PB27A | 5 | BDQ24 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| W10 | PB17A | 5 | BDQ15 | T | PB26A | 5 | BDQ24 | T |
| AA9 | PB18B | 5 | BDQ15 | C | PB27B | 5 | BDQ24 | C |
| V10 | PB17B | 5 | BDQ15 | C | PB26B | 5 | BDQ24 | C |
| GNDIO | GNDIO5 | - | | | GNDIO | - | | |
| Y10 | PB21A | 5 | BDQ24 | T | PB30A | 5 | BDQ33 | T |
| AB9 | PB20A | 5 | BDQ24 | T | PB29A | 5 | BDQ33 | T |
| AA10 | PB21B | 5 | BDQ24 | C | PB30B | 5 | BDQ33 | C |
| AB10 | PB20B | 5 | BDQ24 | C | PB29B | 5 | BDQ33 | C |
| AB11 | PB23A | 5 | BDQ24 | T | PB32A | 5 | BDQ33 | T |
| U10 | PB22A | 5 | BDQ24 | T | PB31A | 5 | BDQ33 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA11 | PB23B | 5 | BDQ24 | C | PB32B | 5 | BDQ33 | C |
| U11 | PB22B | 5 | BDQ24 | C | PB31B | 5 | BDQ33 | C |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AB12 | PB25A | 5 | BDQ24 | T | PB34A | 5 | BDQ33 | T |
| Y11 | PB24A | 5 | BDQS24 | T | PB33A | 5 | BDQS33 | T |
| AA12 | PB25B | 5 | BDQ24 | C | PB34B | 5 | BDQ33 | C |
| W11 | PB24B | 5 | BDQ24 | C | PB33B | 5 | BDQ33 | C |
| AB13 | PB26A | 5 | PCLKT5_0/BDQ24 | T | PB35A | 5 | PCLKT5_0/BDQ33 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AB14 | PB26B | 5 | PCLKC5_0/BDQ24 | C | PB35B | 5 | PCLKC5_0/BDQ33 | C |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| Y12 | PB32A | 4 | BDQ33 | T | PB41A | 4 | BDQ42 | T |
| W12 | PB32B | 4 | BDQ33 | C | PB41B | 4 | BDQ42 | C |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| U12 | PB31A | 4 | PCLKT4_0/BDQ33 | T | PB40A | 4 | PCLKT4_0/BDQ42 | T |
| V12 | PB31B | 4 | PCLKC4_0/BDQ33 | C | PB40B | 4 | PCLKC4_0/BDQ42 | C |
| U13 | PB34A | 4 | BDQ33 | T | PB43A | 4 | BDQ42 | T |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AA13 | PB33A | 4 | BDQS33 | T | PB42A | 4 | BDQS42 | T |
| U14 | PB34B | 4 | BDQ33 | C | PB43B | 4 | BDQ42 | C |
| Y13 | PB33B | 4 | BDQ33 | C | PB42B | 4 | BDQ42 | C |
| AB16 | PB36A | 4 | BDQ33 | T | PB45A | 4 | BDQ42 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AB15 | PB35A | 4 | BDQ33 | T | PB44A | 4 | BDQ42 | T |
| AB17 | PB36B | 4 | BDQ33 | C | PB45B | 4 | BDQ42 | C |
| AA14 | PB35B | 4 | BDQ33 | C | PB44B | 4 | BDQ42 | C |
| W13 | PB37A | 4 | BDQ33 | T | PB46A | 4 | BDQ42 | T |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| W14 | PB37B | 4 | BDQ33 | C | PB46B | 4 | BDQ42 | C |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AB18 | PB39A | 4 | BDQ42 | T | PB48A | 4 | BDQ51 | T |
| AB19 | PB39B | 4 | BDQ42 | C | PB48B | 4 | BDQ51 | C |
| Y15 | PB41A | 4 | BDQ42 | T | PB50A | 4 | BDQ51 | T |
| V14 | PB40A | 4 | BDQ42 | T | PB49A | 4 | BDQ51 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AA15 | PB41B | 4 | BDQ42 | C | PB50B | 4 | BDQ51 | C |
| W15 | PB40B | 4 | BDQ42 | C | PB49B | 4 | BDQ51 | C |
| GNDIO | GNDIO4 | - | | | GNDIO | - | | |
| AB20 | PB43A | 4 | BDQ42 | T | PB52A | 4 | BDQ51 | T |
| AA16 | PB42A | 4 | BDQS42 | T | PB51A | 4 | BDQS51 | T |
| AB21 | PB43B | 4 | BDQ42 | C | PB52B | 4 | BDQ51 | C |
| AA17 | PB42B | 4 | BDQ42 | C | PB51B | 4 | BDQ51 | C |
| Y16 | PB45A | 4 | BDQ42 | T | PB54A | 4 | BDQ51 | T |
| U15 | PB44A | 4 | BDQ42 | T | PB53A | 4 | BDQ51 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| W16 | PB45B | 4 | BDQ42 | C | PB54B | 4 | BDQ51 | C |
| U16 | PB44B | 4 | BDQ42 | C | PB53B | 4 | BDQ51 | C |
| AA18 | PB46A | 4 | BDQ42 | T | PB55A | 4 | BDQ51 | T |
| AA20 | PB46B | 4 | BDQ42 | C | PB55B | 4 | BDQ51 | C |
| GNDIO | GNDIO4 | - | | | GNDIO | - | | |
| V16 | PB49A | 4 | BDQ51 | T | PB58A | 4 | BDQ60 | T |
| V17 | PB49B | 4 | BDQ51 | C | PB58B | 4 | BDQ60 | C |
| AA21 | PB48A | 4 | BDQ51 | T | PB57A | 4 | BDQ60 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| Y19 | PB51A | 4 | BDQS51 | T | PB60A | 4 | BDQS60 | T |
| AA22 | PB48B | 4 | BDQ51 | C | PB57B | 4 | BDQ60 | C |
| Y20 | PB51B | 4 | BDQ51 | C | PB60B | 4 | BDQ60 | C |
| Y18 | PB50A | 4 | BDQ51 | T | PB59A | 4 | BDQ60 | T |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| Y21 | PB53A | 4 | BDQ51 | T | PB62A | 4 | BDQ60 | T |
| Y17 | PB50B | 4 | BDQ51 | C | PB59B | 4 | BDQ60 | C |
| Y22 | PB53B | 4 | BDQ51 | C | PB62B | 4 | BDQ60 | C |
| W17 | PB52A | 4 | BDQ51 | T | PB61A | 4 | BDQ60 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| U18 | PB54A | 4 | BDQ51 | T | PB63A | 4 | BDQ60 | T |
| W18 | PB52B | 4 | BDQ51 | C | PB61B | 4 | BDQ60 | C |
| V18 | PB54B | 4 | BDQ51 | C | PB63B | 4 | BDQ60 | C |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| T15 | PB55A | 4 | VREF2_4/BDQ51 | T | PB64A | 4 | VREF2_4/BDQ60 | T |
| T16 | PB55B | 4 | VREF1_4/BDQ51 | C | PB64B | 4 | VREF1_4/BDQ60 | C |
| W19 | CFG2 | 8 | | | CFG2 | 8 | | |
| V19 | CFG1 | 8 | | | CFG1 | 8 | | |
| V20 | PROGRAMN | 8 | | | PROGRAMN | 8 | | |
| W20 | CFG0 | 8 | | | CFG0 | 8 | | |
| U22 | PR28B | 8 | D1 | C | PR42B | 8 | D1 | C |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|--------------------|--------------|-------------------|------|--------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| V22 | INITN | 8 | | | INITN | 8 | | |
| R16 | PR30B | 8 | WRITEN | C | PR44B | 8 | WRITEN | C |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| W22 | CCLK | 8 | | | CCLK | 8 | | |
| R17 | PR30A | 8 | CS1N | T | PR44A | 8 | CS1N | T |
| V21 | DONE | 8 | | | DONE | 8 | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| U19 | PR29B | 8 | CSN | C | PR43B | 8 | CSN | C |
| T17 | PR26B | 8 | D5 | C | PR40B | 8 | D5 | C |
| U20 | PR29A | 8 | D0/SPIFASTN | T | PR43A | 8 | D0/SPIFASTN | T |
| U21 | PR28A | 8 | D2 | T | PR42A | 8 | D2 | T |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| T18 | PR26A | 8 | D6 | T | PR40A | 8 | D6 | T |
| T20 | PR27B | 8 | D3 | C | PR41B | 8 | D3 | C |
| T21 | PR25B | 8 | D7/SPID0 | C | PR39B | 8 | D7/SPID0 | C |
| T19 | PR27A | 8 | D4 | T | PR41A | 8 | D4 | T |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| T22 | PR25A | 8 | DI/CSSPI0N | T | PR39A | 8 | DI/CSSPI0N | T |
| R18 | PR24B | 8 | DOUT/CSON | C | PR38B | 8 | DOUT/CSON | C |
| R19 | PR24A | 8 | BUSY/SISPI | T | PR38A | 8 | BUSY/SISPI | T |
| - | - | - | | | VCCIO3 | 3 | | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| P18 | PR22B | 3 | | C (LVDS)* | PR32B | 3 | RDQ34 | C (LVDS)* |
| R22 | PR23B | 3 | | C | PR33B | 3 | RDQ34 | C |
| P19 | PR22A | 3 | | T (LVDS)* | PR32A | 3 | RDQ34 | T (LVDS)* |
| R21 | PR23A | 3 | | T | PR33A | 3 | RDQ34 | T |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R20 | PR21B | 3 | RLM0_GPLL_C_FB_A | C | PR31B | 3 | RLM0_GPLL_C_FB_A/RDQ34 | C |
| P22 | PR21A | 3 | RLM0_GPLLT_FB_A | T | PR31A | 3 | RLM0_GPLLT_FB_A/RDQ34 | T |
| P21 | PR20B | 3 | RLM0_GPLL_C_IN_A** | C (LVDS)* | PR30B | 3 | RLM0_GPLL_C_IN_A**/RDQ34 | C (LVDS)* |
| N21 | PR20A | 3 | RLM0_GPLLT_IN_A** | T (LVDS)* | PR30A | 3 | RLM0_GPLLT_IN_A**/RDQ34 | T (LVDS)* |
| N17 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| N22 | PR18B | 3 | RLM0_GDLL_C_FB_A | C | PR28B | 3 | RLM0_GDLL_C_FB_A/RDQ25 | C |
| M22 | PR17B | 3 | RLM0_GDLL_C_IN_A** | C (LVDS)* | PR27B | 3 | RLM0_GDLL_C_IN_A**/RDQ25 | C (LVDS)* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| N20 | PR18A | 3 | RLM0_GDLLT_FB_A | T | PR28A | 3 | RLM0_GDLLT_FB_A/RDQ25 | T |
| M21 | PR17A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* | PR27A | 3 | RLM0_GDLLT_IN_A**/RDQ25 | T (LVDS)* |
| N19 | NC | - | | | PR26B | 3 | RDQ25 | C |
| - | - | - | | | VCCIO3 | 3 | | |
| M19 | NC | - | | | PR26A | 3 | RDQ25 | T |
| J22 | NC | - | | | PR23B | 3 | RDQ25 | C (LVDS)* |
| - | - | - | | | GNDIO | - | | |
| L22 | NC | - | | | PR24B | 3 | RDQ25 | C |
| H22 | NC | - | | | PR23A | 3 | RDQ25 | T (LVDS)* |
| K22 | NC | - | | | PR24A | 3 | RDQ25 | T |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| M20 | PR16B | 3 | VREF2_3 | C | PR22B | 3 | VREF2_3/RDQ25 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| L21 | PR16A | 3 | VREF1_3 | T | PR22A | 3 | VREF1_3/RDQ25 | T |
| K21 | PR15B | 3 | PCLKC3_0 | C (LVDS)* | PR21B | 3 | PCLKC3_0/RDQ25 | C (LVDS)* |
| J21 | PR15A | 3 | PCLKT3_0 | T (LVDS)* | PR21A | 3 | PCLKT3_0/RDQ25 | T (LVDS)* |
| M18 | PR13B | 2 | PCLKC2_0/RDQ10 | C | PR19B | 2 | PCLKC2_0/RDQ16 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| L17 | PR13A | 2 | PCLKT2_0/RDQ10 | T | PR19A | 2 | PCLKT2_0/RDQ16 | T |
| L19 | PR12B | 2 | RDQ10 | C (LVDS)* | PR18B | 2 | RDQ16 | C (LVDS)* |
| K18 | PR10B | 2 | RDQ10 | C (LVDS)* | PR16B | 2 | RDQ16 | C (LVDS)* |
| L20 | PR12A | 2 | RDQ10 | T (LVDS)* | PR18A | 2 | RDQ16 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K19 | PR10A | 2 | RDQS10 | T (LVDS)* | PR16A | 2 | RDQS16 | T (LVDS)* |
| L18 | PR11B | 2 | RDQ10 | C | PR17B | 2 | RDQ16 | C |
| K17 | PR11A | 2 | RDQ10 | T | PR17A | 2 | RDQ16 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| J17 | PR8B | 2 | RDQ10 | C (LVDS)* | PR14B | 2 | RDQ16 | C (LVDS)* |
| G22 | PR9B | 2 | RDQ10 | C | PR15B | 2 | RDQ16 | C |
| J18 | PR8A | 2 | RDQ10 | T (LVDS)* | PR14A | 2 | RDQ16 | T (LVDS)* |
| F22 | PR9A | 2 | RDQ10 | T | PR15A | 2 | RDQ16 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H21 | PR6B | 2 | RDQ10 | C (LVDS)* | PR12B | 2 | RDQ16 | C (LVDS)* |
| K20 | PR7B | 2 | RDQ10 | C | PR13B | 2 | RDQ16 | C |
| G21 | PR6A | 2 | RDQ10 | T (LVDS)* | PR12A | 2 | RDQ16 | T (LVDS)* |
| J19 | PR7A | 2 | RDQ10 | T | PR13A | 2 | RDQ16 | T |
| D22 | NC | - | | | PR10B | 2 | RDQ8 | C (LVDS)* |
| F21 | NC | - | | | PR11B | 2 | RDQ8 | C |
| - | - | - | | | GNDIO | - | | |
| E21 | NC | - | | | PR10A | 2 | RDQ8 | T (LVDS)* |
| E22 | NC | - | | | PR11A | 2 | RDQ8 | T |
| H19 | NC | - | | | PR8B | 2 | RDQ8 | C (LVDS)* |
| G20 | NC | - | | | PR9B | 2 | RDQ8 | C |
| - | - | - | | | VCCIO2 | 2 | | |
| G19 | NC | - | | | PR8A | 2 | RDQS8 | T (LVDS)* |
| F20 | NC | - | | | PR9A | 2 | RDQ8 | T |
| G17 | PR5B | 2 | | C | PR7B | 2 | RDQ8 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| E20 | PR4B | 2 | | C (LVDS)* | PR6B | 2 | RDQ8 | C (LVDS)* |
| F19 | PR5A | 2 | | T | PR7A | 2 | RDQ8 | T |
| D20 | PR4A | 2 | | T (LVDS)* | PR6A | 2 | RDQ8 | T (LVDS)* |
| F18 | PR3B | 2 | | C | PR5B | 2 | RDQ8 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| C21 | NC | - | | | PR4B | 2 | RDQ8 | C (LVDS)* |
| F16 | PR3A | 2 | | T | PR5A | 2 | RDQ8 | T |
| C22 | NC | - | | | PR4A | 2 | RDQ8 | T (LVDS)* |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| - | - | - | | | GNDIO | - | | |
| D19 | PR2B | 2 | VREF2_2 | C (LVDS)* | PR2B | 2 | VREF2_2 | C (LVDS)* |
| E19 | PR2A | 2 | VREF1_2 | T (LVDS)* | PR2A | 2 | VREF1_2 | T (LVDS)* |
| B21 | PT55B | 1 | VREF2_1 | C | PT64B | 1 | VREF2_1 | C |
| B22 | PT55A | 1 | VREF1_1 | T | PT64A | 1 | VREF1_1 | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| D18 | PT53B | 1 | | C | PT62B | 1 | | C |
| C20 | PT54B | 1 | | C | PT63B | 1 | | C |
| E18 | PT53A | 1 | | T | PT62A | 1 | | T |
| C19 | PT54A | 1 | | T | PT63A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D17 | PT51B | 1 | | C | PT60B | 1 | | C |
| B20 | PT52B | 1 | | C | PT61B | 1 | | C |
| C18 | PT51A | 1 | | T | PT60A | 1 | | T |
| A19 | PT52A | 1 | | T | PT61A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| A18 | PT49B | 1 | | C | PT58B | 1 | | C |
| A21 | PT50B | 1 | | C | PT59B | 1 | | C |
| B18 | PT49A | 1 | | T | PT58A | 1 | | T |
| A20 | PT50A | 1 | | T | PT59A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D16 | PT47B | 1 | | C | PT56B | 1 | | C |
| G16 | PT48B | 1 | | C | PT57B | 1 | | C |
| E16 | PT47A | 1 | | T | PT56A | 1 | | T |
| G15 | PT48A | 1 | | T | PT57A | 1 | | T |
| C17 | PT46B | 1 | | C | PT55B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| C16 | PT46A | 1 | | T | PT55A | 1 | | T |
| A17 | PT44B | 1 | | C | PT53B | 1 | | C |
| B17 | PT45B | 1 | | C | PT54B | 1 | | C |
| A16 | PT44A | 1 | | T | PT53A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| B16 | PT45A | 1 | | T | PT54A | 1 | | T |
| E15 | PT42B | 1 | | C | PT51B | 1 | | C |
| C15 | PT43B | 1 | | C | PT52B | 1 | | C |
| F15 | PT42A | 1 | | T | PT51A | 1 | | T |
| D15 | PT43A | 1 | | T | PT52A | 1 | | T |
| B15 | PT40B | 1 | | C | PT49B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| A15 | PT40A | 1 | | T | PT49A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A14 | PT39A | 1 | | T | PT48A | 1 | | T |
| B14 | PT39B | 1 | | C | PT48B | 1 | | C |
| D14 | PT37B | 1 | | C | PT46B | 1 | | C |
| E14 | PT36B | 1 | | C | PT45B | 1 | | C |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| C13 | PT37A | 1 | | T | PT46A | 1 | | T |
| F14 | PT36A | 1 | | T | PT45A | 1 | | T |
| A13 | PT35B | 1 | | C | PT44B | 1 | | C |
| E13 | PT34B | 1 | | C | PT43B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| B13 | PT35A | 1 | | T | PT44A | 1 | | T |
| D13 | PT34A | 1 | | T | PT43A | 1 | | T |
| E12 | PT33B | 1 | | C | PT42B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| D12 | PT33A | 1 | | T | PT42A | 1 | | T |
| A12 | PT31B | 1 | | C | PT40B | 1 | | C |
| B12 | PT30B | 1 | PCLKC1_0 | C | PT39B | 1 | PCLKC1_0 | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A11 | PT31A | 1 | | T | PT40A | 1 | | T |
| C12 | PT30A | 1 | PCLKT1_0 | T | PT39A | 1 | PCLKT1_0 | T |
| F12 | XRES | 1 | | | XRES | 1 | | |
| B10 | PT28B | 0 | PCLKC0_0 | C | PT37B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| B11 | PT28A | 0 | PCLKT0_0 | T | PT37A | 0 | PCLKT0_0 | T |
| C11 | PT26B | 0 | | C | PT35B | 0 | | C |
| A10 | PT27B | 0 | | C | PT36B | 0 | | C |
| C10 | PT26A | 0 | | T | PT35A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| A9 | PT27A | 0 | | T | PT36A | 0 | | T |
| A8 | PT24B | 0 | | C | PT33B | 0 | | C |
| E11 | PT25B | 0 | | C | PT34B | 0 | | C |
| A7 | PT24A | 0 | | T | PT33A | 0 | | T |
| F11 | PT25A | 0 | | T | PT34A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| B8 | PT23B | 0 | | C | PT32B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| B9 | PT23A | 0 | | T | PT32A | 0 | | T |
| C8 | PT20B | 0 | | C | PT29B | 0 | | C |
| B7 | PT21B | 0 | | C | PT30B | 0 | | C |
| D8 | PT20A | 0 | | T | PT29A | 0 | | T |
| A6 | PT21A | 0 | | T | PT30A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| C7 | PT17B | 0 | | C | PT26B | 0 | | C |
| D10 | PT18B | 0 | | C | PT27B | 0 | | C |
| C6 | PT17A | 0 | | T | PT26A | 0 | | T |
| E10 | PT18A | 0 | | T | PT27A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F10 | PT15B | 0 | | C | PT24B | 0 | | C |
| B6 | PT16B | 0 | | C | PT25B | 0 | | C |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D9 | PT15A | 0 | | T | PT24A | 0 | | T |
| B5 | PT16A | 0 | | T | PT25A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| A5 | PT13B | 0 | | C | PT22B | 0 | | C |
| F9 | PT14B | 0 | | C | PT23B | 0 | | C |
| A4 | PT13A | 0 | | T | PT22A | 0 | | T |
| E9 | PT14A | 0 | | T | PT23A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G8 | PT11B | 0 | | C | PT20B | 0 | | C |
| A3 | PT12B | 0 | | C | PT21B | 0 | | C |
| E8 | PT11A | 0 | | T | PT20A | 0 | | T |
| A2 | PT12A | 0 | | T | PT21A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| - | - | - | | | VCCIO0 | 0 | | |
| C3 | PT10B | 0 | | C | PT10B | 0 | | C |
| B3 | PT10A | 0 | | T | PT10A | 0 | | T |
| - | - | - | | | GNDIO0 | - | | |
| E7 | PT8B | 0 | | C | PT8B | 0 | | C |
| F8 | PT9B | 0 | | C | PT9B | 0 | | C |
| F7 | PT8A | 0 | | T | PT8A | 0 | | T |
| D7 | PT9A | 0 | | T | PT9A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D4 | PT6B | 0 | | C | PT6B | 0 | | C |
| D5 | PT7B | 0 | | C | PT7B | 0 | | C |
| C4 | PT6A | 0 | | T | PT6A | 0 | | T |
| D6 | PT7A | 0 | | T | PT7A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO | - | | |
| J7 | PT4B | 0 | | C | PT4B | 0 | | C |
| B2 | PT5B | 0 | | C | PT5B | 0 | | C |
| H7 | PT4A | 0 | | T | PT4A | 0 | | T |
| B1 | PT5A | 0 | | T | PT5A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D1 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| D3 | PT3B | 0 | | C | PT3B | 0 | | C |
| C1 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |
| C2 | PT3A | 0 | | T | PT3A | 0 | | T |
| J10 | VCC | - | | | VCC | - | | |
| J11 | VCC | - | | | VCC | - | | |
| J12 | VCC | - | | | VCC | - | | |
| J13 | VCC | - | | | VCC | - | | |
| K14 | VCC | - | | | VCC | - | | |
| K9 | VCC | - | | | VCC | - | | |
| L14 | VCC | - | | | VCC | - | | |
| L9 | VCC | - | | | VCC | - | | |
| M14 | VCC | - | | | VCC | - | | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| M9 | VCC | - | | | VCC | - | | |
| N14 | VCC | - | | | VCC | - | | |
| N9 | VCC | - | | | VCC | - | | |
| P10 | VCC | - | | | VCC | - | | |
| P11 | VCC | - | | | VCC | - | | |
| P12 | VCC | - | | | VCC | - | | |
| P13 | VCC | - | | | VCC | - | | |
| G10 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H8 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G11 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G12 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G13 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G14 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H14 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H15 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J15 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K16 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| M16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| N16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| P16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R14 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| T12 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| T13 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| T14 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| R9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T10 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T11 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| N7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| P7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| P8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| J8 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| P15 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| R15 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| C5 | VCCAUX | - | | | VCCAUX | - | | |
| D11 | VCCAUX | - | | | VCCAUX | - | | |
| E17 | VCCAUX | - | | | VCCAUX | - | | |
| E6 | VCCAUX | - | | | VCCAUX | - | | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F13 | VCCAUX | - | | | VCCAUX | - | | |
| G18 | VCCAUX | - | | | VCCAUX | - | | |
| G5 | VCCAUX | - | | | VCCAUX | - | | |
| K5 | VCCAUX | - | | | VCCAUX | - | | |
| M17 | VCCAUX | - | | | VCCAUX | - | | |
| P17 | VCCAUX | - | | | VCCAUX | - | | |
| R5 | VCCAUX | - | | | VCCAUX | - | | |
| V11 | VCCAUX | - | | | VCCAUX | - | | |
| V13 | VCCAUX | - | | | VCCAUX | - | | |
| V15 | VCCAUX | - | | | VCCAUX | - | | |
| V7 | VCCAUX | - | | | VCCAUX | - | | |
| V8 | VCCAUX | - | | | VCCAUX | - | | |
| A1 | GND | - | | | GND | - | | |
| A22 | GND | - | | | GND | - | | |
| AA19 | GND | - | | | GND | - | | |
| AA4 | GND | - | | | GND | - | | |
| AB1 | GND | - | | | GND | - | | |
| AB22 | GND | - | | | GND | - | | |
| B19 | GND | - | | | GND | - | | |
| B4 | GND | - | | | GND | - | | |
| C14 | GND | - | | | GND | - | | |
| C9 | GND | - | | | GND | - | | |
| D2 | GND | - | | | GND | - | | |
| D21 | GND | - | | | GND | - | | |
| F17 | GND | - | | | GND | - | | |
| F6 | GND | - | | | GND | - | | |
| H10 | GND | - | | | GND | - | | |
| H11 | GND | - | | | GND | - | | |
| H12 | GND | - | | | GND | - | | |
| H13 | GND | - | | | GND | - | | |
| J14 | GND | - | | | GND | - | | |
| J20 | GND | - | | | GND | - | | |
| J3 | GND | - | | | GND | - | | |
| J9 | GND | - | | | GND | - | | |
| K10 | GND | - | | | GND | - | | |
| K11 | GND | - | | | GND | - | | |
| K12 | GND | - | | | GND | - | | |
| K13 | GND | - | | | GND | - | | |
| K15 | GND | - | | | GND | - | | |
| K8 | GND | - | | | GND | - | | |
| L10 | GND | - | | | GND | - | | |
| L11 | GND | - | | | GND | - | | |
| L12 | GND | - | | | GND | - | | |
| L13 | GND | - | | | GND | - | | |
| L15 | GND | - | | | GND | - | | |

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA

| LFE2-12E/12SE | | | | | LFE2-20E/20SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| L8 | GND | - | | | GND | - | | |
| M10 | GND | - | | | GND | - | | |
| M11 | GND | - | | | GND | - | | |
| M12 | GND | - | | | GND | - | | |
| M13 | GND | - | | | GND | - | | |
| M15 | GND | - | | | GND | - | | |
| M8 | GND | - | | | GND | - | | |
| N10 | GND | - | | | GND | - | | |
| N11 | GND | - | | | GND | - | | |
| N12 | GND | - | | | GND | - | | |
| N13 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N8 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P20 | GND | - | | | GND | - | | |
| P3 | GND | - | | | GND | - | | |
| P9 | GND | - | | | GND | - | | |
| R10 | GND | - | | | GND | - | | |
| R11 | GND | - | | | GND | - | | |
| R12 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| U17 | GND | - | | | GND | - | | |
| U6 | GND | - | | | GND | - | | |
| W2 | GND | - | | | GND | - | | |
| W21 | GND | - | | | GND | - | | |
| Y14 | GND | - | | | GND | - | | |
| Y9 | GND | - | | | GND | - | | |
| H6 | NC | - | | | NC | - | | |
| J6 | NC | - | | | NC | - | | |
| H3 | NC | - | | | NC | - | | |
| H2 | NC | - | | | NC | - | | |
| H17 | NC | - | | | NC | - | | |
| H16 | NC | - | | | NC | - | | |
| H20 | NC | - | | | NC | - | | |
| H18 | NC | - | | | NC | - | | |
| K6 | NC | - | | | NC | - | | |
| J16 | NC | - | | | NC | - | | |
| N18 | VCC | - | | | VCC | - | | |
| N6 | VCC | - | | | VCC | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E4 | PL2A | 7 | VREF2_7/LDQ6 | T (LVDS)* | PL2A | 7 | VREF2_7 | T (LVDS)* |
| E5 | PL2B | 7 | VREF1_7/LDQ6 | C (LVDS)* | PL2B | 7 | VREF1_7 | C (LVDS)* |
| VCCIO | VCCIO7 | - | | | GNDIO7 | - | | |
| GNDIO | GNDIO7 | - | | | VCCIO | 7 | | |
| E3 | PL10A | 7 | LDQ14 | T (LVDS)* | PL12A | 7 | LDQ16 | T (LVDS)* |
| F3 | PL10B | 7 | LDQ14 | C (LVDS)* | PL12B | 7 | LDQ16 | C (LVDS)* |
| F4 | PL11A | 7 | LDQ14 | T | PL13A | 7 | LDQ16 | T |
| F5 | PL11B | 7 | LDQ14 | C | PL13B | 7 | LDQ16 | C |
| E2 | PL12A | 7 | LDQ14 | T (LVDS)* | PL14A | 7 | LDQ16 | T (LVDS)* |
| VCCIO | VCCIO7 | 7 | | | VCCIO | 7 | | |
| E1 | PL12B | 7 | LDQ14 | C (LVDS)* | PL14B | 7 | LDQ16 | C (LVDS)* |
| G6 | PL13A | 7 | LDQ14 | T | PL15A | 7 | LDQ16 | T |
| G7 | PL13B | 7 | LDQ14 | C | PL15B | 7 | LDQ16 | C |
| H4 | PL14A | 7 | LDQS14 | T (LVDS)* | PL16A | 7 | LDQS16 | T (LVDS)* |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| H5 | PL14B | 7 | LDQ14 | C (LVDS)* | PL16B | 7 | LDQ16 | C (LVDS)* |
| F1 | PL15A | 7 | LDQ14 | T | PL17A | 7 | LDQ16 | T |
| F2 | PL15B | 7 | LDQ14 | C | PL17B | 7 | LDQ16 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO | 7 | | |
| G3 | PL16A | 7 | LDQ14 | T (LVDS)* | PL18A | 7 | LDQ16 | T (LVDS)* |
| G4 | PL16B | 7 | LDQ14 | C (LVDS)* | PL18B | 7 | LDQ16 | C (LVDS)* |
| G1 | PL17A | 7 | LDQ14 | T | PL19A | 7 | LDQ16 | T |
| G2 | PL17B | 7 | LDQ14 | C | PL19B | 7 | LDQ16 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| - | - | - | | | VCCIO | 7 | | |
| H6 | NC | - | | | PL25A | 7 | LUM0_SPLLT_IN_A/LDQ24 | T |
| - | - | - | | | VCCIO | 7 | | |
| J6 | NC | - | | | PL25B | 7 | LUM0_SPLLC_IN_A/LDQ24 | C |
| H3 | NC | - | | | PL26A | 7 | LUM0_SPLLT_FB_A/LDQ24 | T |
| H2 | NC | - | | | PL26B | 7 | LUM0_SPLLC_FB_A/LDQ24 | C |
| - | - | - | | | GNDIO7 | - | | |
| - | - | - | | | VCCIO | 7 | | |
| H1 | PL18A | 7 | LDQ22 | | PL37A | 7 | LDQ41 | |
| J4 | PL19A | 7 | LDQ22 | T | PL38A | 7 | LDQ41 | T |
| J5 | PL19B | 7 | LDQ22 | C | PL38B | 7 | LDQ41 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO | 7 | | |
| J2 | PL20A | 7 | LDQ22 | T (LVDS)* | PL39A | 7 | LDQ41 | T (LVDS)* |
| J1 | PL20B | 7 | LDQ22 | C (LVDS)* | PL39B | 7 | LDQ41 | C (LVDS)* |
| L6 | PL21A | 7 | LDQ22 | T | PL40A | 7 | LDQ41 | T |
| L5 | PL21B | 7 | LDQ22 | C | PL40B | 7 | LDQ41 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| K3 | PL22A | 7 | LDQS22 | T (LVDS)* | PL41A | 7 | LDQS41 | T (LVDS)* |
| K4 | PL22B | 7 | LDQ22 | C (LVDS)* | PL41B | 7 | LDQ41 | C (LVDS)* |
| K2 | PL23A | 7 | LDQ22 | T | PL42A | 7 | LDQ41 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO | 7 | | |
| K1 | PL23B | 7 | LDQ22 | C | PL42B | 7 | LDQ41 | C |
| L4 | PL24A | 7 | LDQ22 | T (LVDS)* | PL43A | 7 | LDQ41 | T (LVDS)* |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|-------------------------|--------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| L3 | PL24B | 7 | LDQ22 | C (LVDS)* | PL43B | 7 | LDQ41 | C (LVDS)* |
| L2 | PL25A | 7 | PCLKT7_0/LDQ22 | T | PL44A | 7 | PCLKT7_0/LDQ41 | T |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| L1 | PL25B | 7 | PCLKC7_0/LDQ22 | C | PL44B | 7 | PCLKC7_0/LDQ41 | C |
| M5 | PL27A | 6 | PCLKT6_0/LDQ31 | T (LVDS)* | PL46A | 6 | PCLKT6_0/LDQ50 | T (LVDS)* |
| M6 | PL27B | 6 | PCLKC6_0/LDQ31 | C (LVDS)* | PL46B | 6 | PCLKC6_0/LDQ50 | C (LVDS)* |
| M3 | PL28A | 6 | VREF2_6/LDQ31 | T | PL47A | 6 | VREF2_6/LDQ50 | T |
| M4 | PL28B | 6 | VREF1_6/LDQ31 | C | PL47B | 6 | VREF1_6/LDQ50 | C |
| M2 | PL29A | 6 | LDQ31 | T (LVDS)* | PL48A | 6 | LDQ50 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO | 6 | | |
| M1 | PL29B | 6 | LDQ31 | C (LVDS)* | PL48B | 6 | LDQ50 | C (LVDS)* |
| N1 | PL30A | 6 | LDQ31 | T | PL49A | 6 | LDQ50 | T |
| N2 | PL30B | 6 | LDQ31 | C | PL49B | 6 | LDQ50 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| VCCIO | VCCIO6 | 6 | | | VCCIO | 6 | | |
| N3 | PL39A | 6 | LDQS39*** | T (LVDS)* | PL58A | 6 | LDQS58*** | T (LVDS)* |
| N4 | PL39B | 6 | LDQ39 | C (LVDS)* | PL58B | 6 | LDQ58 | C (LVDS)* |
| N5 | PL40A | 6 | LDQ39 | T | PL59A | 6 | LDQ58 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO | 6 | | |
| P5 | PL40B | 6 | LDQ39 | C | PL59B | 6 | LDQ58 | C |
| P1 | PL41A | 6 | LLM0_GDLLT_IN_A**/LDQ39 | T (LVDS)* | PL60A | 6 | LLM0_GDLLT_IN_A**/LDQ58 | T (LVDS)* |
| P2 | PL41B | 6 | LLM0_GDLLC_IN_A**/LDQ39 | C (LVDS)* | PL60B | 6 | LLM0_GDLLC_IN_A**/LDQ58 | C (LVDS)* |
| P4 | PL42A | 6 | LLM0_GDLLT_FB_A/LDQ39 | T | PL61A | 6 | LLM0_GDLLT_FB_A/LDQ58 | T |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| R4 | PL42B | 6 | LLM0_GDLLC_FB_A/LDQ39 | C | PL61B | 6 | LLM0_GDLLC_FB_D/LDQ58 | C |
| P6 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | |
| R1 | PL44A | 6 | LLM0_GPLLT_IN_A**/LDQ48 | T (LVDS)* | PL63A | 6 | LLM0_GPLLT_IN_A**/LDQ67 | T (LVDS)* |
| R2 | PL44B | 6 | LLM0_GPLLC_IN_A**/LDQ48 | C (LVDS)* | PL63B | 6 | LLM0_GPLLC_IN_A**/LDQ67 | C (LVDS)* |
| R3 | PL45A | 6 | LLM0_GPLLT_FB_A/LDQ48 | T | PL64A | 6 | LLM0_GPLLT_FB_A/LDQ67 | T |
| T4 | PL45B | 6 | LLM0_GPLLC_FB_A/LDQ48 | C | PL64B | 6 | LLM0_GPLLC_FB_A/LDQ67 | C |
| T1 | PL46A | 6 | LDQ48 | T (LVDS)* | PL65A | 6 | LDQ67 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO | 6 | | |
| T2 | PL46B | 6 | LDQ48 | C (LVDS)* | PL65B | 6 | LDQ67 | C (LVDS)* |
| T5 | PL47A | 6 | LDQ48 | T | PL66A | 6 | LDQ67 | T |
| T3 | PL47B | 6 | LDQ48 | C | PL66B | 6 | LDQ67 | C |
| GNDIO | GNDIO6 | - | | | VCCIO | 6 | | |
| VCCIO | VCCIO6 | - | | | GNDIO6 | - | | |
| U1 | PL52A | 6 | LDQ56 | T (LVDS)* | PL71A | 6 | LDQ75 | T (LVDS)* |
| U2 | PL52B | 6 | LDQ56 | C (LVDS)* | PL71B | 6 | LDQ75 | C (LVDS)* |
| V1 | PL53A | 6 | LDQ56 | T | PL72A | 6 | LDQ75 | T |
| V2 | PL53B | 6 | LDQ56 | C | PL72B | 6 | LDQ75 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO | 6 | | |
| R6 | PL54A | 6 | LDQ56 | T (LVDS)* | PL73A | 6 | LDQ75 | T (LVDS)* |
| T6 | PL54B | 6 | LDQ56 | C (LVDS)* | PL73B | 6 | LDQ75 | C (LVDS)* |
| U3 | PL55A | 6 | LDQ56 | T | PL74A | 6 | LDQ75 | T |
| U4 | PL55B | 6 | LDQ56 | C | PL74B | 6 | LDQ75 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| Y1 | PL56A | 6 | LDQS56 | T (LVDS)* | PL75A | 6 | LDQS75 | T (LVDS)* | |
| W1 | PL56B | 6 | LDQ56 | C (LVDS)* | PL75B | 6 | LDQ75 | C (LVDS)* | |
| R7 | PL57A | 6 | LDQ56 | T | PL76A | 6 | LDQ75 | T | |
| VCCIO | VCCIO6 | 6 | | | VCCIO | 6 | | | |
| T7 | PL57B | 6 | LDQ56 | C | PL76B | 6 | LDQ75 | C | |
| V4 | PL58A | 6 | LDQ56 | T (LVDS)* | PL77A | 6 | LDQ75 | T (LVDS)* | |
| V3 | PL58B | 6 | LDQ56 | C (LVDS)* | PL77B | 6 | LDQ75 | C (LVDS)* | |
| AA2 | PL59A | 6 | LDQ56 | T | PL78A | 6 | LDQ75 | T | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| AA1 | PL59B | 6 | LDQ56 | C | PL78B | 6 | LDQ75 | C | |
| U7 | TCK | - | | | TCK | - | | | |
| U5 | TDI | - | | | TDI | - | | | |
| V5 | TMS | - | | | TMS | - | | | |
| V6 | TDO | - | | | TDO | - | | | |
| T8 | VCCJ | - | | | VCCJ | - | | | |
| Y3 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T | |
| Y2 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C | |
| W4 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T | |
| W3 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C | |
| W5 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T | |
| W6 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| AB3 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T | |
| AB2 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| Y4 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T | |
| AA3 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C | |
| AB5 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T | |
| AB4 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C | |
| AA5 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T | |
| Y5 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| AB6 | PB9A | 5 | BDQ6 | T | PB9A | 5 | BDQ6 | T | |
| AA6 | PB9B | 5 | BDQ6 | C | PB9B | 5 | BDQ6 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| W7 | PB20A | 5 | BDQ24 | T | PB29A | 5 | BDQ33 | T | |
| W8 | PB20B | 5 | BDQ24 | C | PB29B | 5 | BDQ33 | C | |
| Y6 | PB21A | 5 | BDQ24 | T | PB30A | 5 | BDQ33 | T | |
| Y7 | PB21B | 5 | BDQ24 | C | PB30B | 5 | BDQ33 | C | |
| AA7 | PB22A | 5 | BDQ24 | T | PB31A | 5 | BDQ33 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| AB7 | PB22B | 5 | BDQ24 | C | PB31B | 5 | BDQ33 | C | |
| U8 | PB23A | 5 | BDQ24 | T | PB32A | 5 | BDQ33 | T | |
| U9 | PB23B | 5 | BDQ24 | C | PB32B | 5 | BDQ33 | C | |
| W9 | PB24A | 5 | BDQS24 | T | PB33A | 5 | BDQS33 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| V9 | PB24B | 5 | BDQ24 | C | PB33B | 5 | BDQ33 | C | |
| Y8 | PB25A | 5 | BDQ24 | T | PB34A | 5 | BDQ33 | T | |
| AA8 | PB25B | 5 | BDQ24 | C | PB34B | 5 | BDQ33 | C | |
| W10 | PB26A | 5 | BDQ24 | T | PB35A | 5 | BDQ33 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| V10 | PB26B | 5 | BDQ24 | C | PB35B | 5 | BDQ33 | C | |
| AB8 | PB27A | 5 | BDQ24 | T | PB36A | 5 | BDQ33 | T | |
| AA9 | PB27B | 5 | BDQ24 | C | PB36B | 5 | BDQ33 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AB9 | PB29A | 5 | BDQ33 | T | PB38A | 5 | BDQ42 | T | |
| AB10 | PB29B | 5 | BDQ33 | C | PB38B | 5 | BDQ42 | C | |
| Y10 | PB30A | 5 | BDQ33 | T | PB39A | 5 | BDQ42 | T | |
| AA10 | PB30B | 5 | BDQ33 | C | PB39B | 5 | BDQ42 | C | |
| U10 | PB31A | 5 | BDQ33 | T | PB40A | 5 | BDQ42 | T | |
| U11 | PB31B | 5 | BDQ33 | C | PB40B | 5 | BDQ42 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| AB11 | PB32A | 5 | BDQ33 | T | PB41A | 5 | BDQ42 | T | |
| AA11 | PB32B | 5 | BDQ33 | C | PB41B | 5 | BDQ42 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| Y11 | PB33A | 5 | BDQS33 | T | PB42A | 5 | BDQS42 | T | |
| W11 | PB33B | 5 | BDQ33 | C | PB42B | 5 | BDQ42 | C | |
| AB12 | PB34A | 5 | BDQ33 | T | PB43A | 5 | BDQ42 | T | |
| AA12 | PB34B | 5 | BDQ33 | C | PB43B | 5 | BDQ42 | C | |
| AB13 | PB35A | 5 | PCLKT5_0/BDQ33 | T | PB44A | 5 | PCLKT5_0/BDQ42 | T | |
| AB14 | PB35B | 5 | PCLKC5_0/BDQ33 | C | PB44B | 5 | PCLKC5_0/BDQ42 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| U12 | PB40A | 4 | PCLKT4_0/BDQ42 | T | PB49A | 4 | PCLKT4_0/BDQ51 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| V12 | PB40B | 4 | PCLKC4_0/BDQ42 | C | PB49B | 4 | PCLKC4_0/BDQ51 | C | |
| Y12 | PB41A | 4 | BDQ42 | T | PB50A | 4 | BDQ51 | T | |
| W12 | PB41B | 4 | BDQ42 | C | PB50B | 4 | BDQ51 | C | |
| AA13 | PB42A | 4 | BDQS42 | T | PB51A | 4 | BDQS51 | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| Y13 | PB42B | 4 | BDQ42 | C | PB51B | 4 | BDQ51 | C | |
| U13 | PB43A | 4 | BDQ42 | T | PB52A | 4 | BDQ51 | T | |
| U14 | PB43B | 4 | BDQ42 | C | PB52B | 4 | BDQ51 | C | |
| AB15 | PB44A | 4 | BDQ42 | T | PB53A | 4 | BDQ51 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| AA14 | PB44B | 4 | BDQ42 | C | PB53B | 4 | BDQ51 | C | |
| AB16 | PB45A | 4 | BDQ42 | T | PB54A | 4 | BDQ51 | T | |
| AB17 | PB45B | 4 | BDQ42 | C | PB54B | 4 | BDQ51 | C | |
| W13 | PB46A | 4 | BDQ42 | T | PB55A | 4 | BDQ51 | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| W14 | PB46B | 4 | BDQ42 | C | PB55B | 4 | BDQ51 | C | |
| AB18 | PB48A | 4 | BDQ51 | T | PB57A | 4 | BDQ60 | T | |
| AB19 | PB48B | 4 | BDQ51 | C | PB57B | 4 | BDQ60 | C | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| V14 | PB49A | 4 | BDQ51 | T | PB58A | 4 | BDQ60 | T | |
| W15 | PB49B | 4 | BDQ51 | C | PB58B | 4 | BDQ60 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| Y15 | PB50A | 4 | BDQ51 | T | PB59A | 4 | BDQ60 | T | |
| AA15 | PB50B | 4 | BDQ51 | C | PB59B | 4 | BDQ60 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA16 | PB51A | 4 | BDQS51 | T | PB60A | 4 | BDQS60 | T | |
| AA17 | PB51B | 4 | BDQ51 | C | PB60B | 4 | BDQ60 | C | |
| AB20 | PB52A | 4 | BDQ51 | T | PB61A | 4 | BDQ60 | T | |
| AB21 | PB52B | 4 | BDQ51 | C | PB61B | 4 | BDQ60 | C | |
| U15 | PB53A | 4 | BDQ51 | T | PB62A | 4 | BDQ60 | T | |
| U16 | PB53B | 4 | BDQ51 | C | PB62B | 4 | BDQ60 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| Y16 | PB54A | 4 | BDQ51 | T | PB63A | 4 | BDQ60 | T | |
| W16 | PB54B | 4 | BDQ51 | C | PB63B | 4 | BDQ60 | C | |
| AA18 | PB55A | 4 | BDQ51 | T | PB64A | 4 | BDQ60 | T | |
| AA20 | PB55B | 4 | BDQ51 | C | PB64B | 4 | BDQ60 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| AA21 | PB66A | 4 | BDQ69 | T | PB75A | 4 | BDQ78 | T | |
| AA22 | PB66B | 4 | BDQ69 | C | PB75B | 4 | BDQ78 | C | |
| V16 | PB67A | 4 | BDQ69 | T | PB76A | 4 | BDQ78 | T | |
| V17 | PB67B | 4 | BDQ69 | C | PB76B | 4 | BDQ78 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| Y18 | PB68A | 4 | BDQ69 | T | PB77A | 4 | BDQ78 | T | |
| Y17 | PB68B | 4 | BDQ69 | C | PB77B | 4 | BDQ78 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| Y19 | PB69A | 4 | BDQS69 | T | PB78A | 4 | BDQS78 | T | |
| Y20 | PB69B | 4 | BDQ69 | C | PB78B | 4 | BDQ78 | C | |
| W17 | PB70A | 4 | BDQ69 | T | PB79A | 4 | BDQ78 | T | |
| W18 | PB70B | 4 | BDQ69 | C | PB79B | 4 | BDQ78 | C | |
| Y21 | PB71A | 4 | BDQ69 | T | PB80A | 4 | BDQ78 | T | |
| Y22 | PB71B | 4 | BDQ69 | C | PB80B | 4 | BDQ78 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO | 4 | | | |
| U18 | PB72A | 4 | BDQ69 | T | PB81A | 4 | BDQ78 | T | |
| V18 | PB72B | 4 | BDQ69 | C | PB81B | 4 | BDQ78 | C | |
| T15 | PB73A | 4 | VREF2_4/BDQ69 | T | PB82A | 4 | VREF2_4/BDQ78 | T | |
| T16 | PB73B | 4 | VREF1_4/BDQ69 | C | PB82B | 4 | VREF1_4/BDQ78 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| W19 | CFG2 | 8 | | | CFG2 | 8 | | | |
| V19 | CFG1 | 8 | | | CFG1 | 8 | | | |
| W20 | CFG0 | 8 | | | CFG0 | 8 | | | |
| V20 | PROGRAMN | 8 | | | PROGRAMN | 8 | | | |
| W22 | CCLK | 8 | | | CCLK | 8 | | | |
| V22 | INITN | 8 | | | INITN | 8 | | | |
| V21 | DONE | 8 | | | DONE | 8 | | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | | |
|-------------|-------------------|------|--------------------------|--------------|-------------------|------|--------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| R16 | PR58B | 8 | WRITEN | C | PR77B | 8 | WRITEN | C | |
| R17 | PR58A | 8 | CS1N | T | PR77A | 8 | CS1N | T | |
| U19 | PR57B | 8 | CSN | C | PR76B | 8 | CSN | C | |
| U20 | PR57A | 8 | D0/SPIFASTN | T | PR76A | 8 | D0/SPIFASTN | T | |
| VCCIO | VCCIO8 | 8 | | | VCCIO | 8 | | | |
| U22 | PR56B | 8 | D1 | C | PR75B | 8 | D1 | C | |
| U21 | PR56A | 8 | D2 | T | PR75A | 8 | D2 | T | |
| T20 | PR55B | 8 | D3 | C | PR74B | 8 | D3 | C | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | | |
| T19 | PR55A | 8 | D4 | T | PR74A | 8 | D4 | T | |
| T17 | PR54B | 8 | D5 | C | PR73B | 8 | D5 | C | |
| T18 | PR54A | 8 | D6 | T | PR73A | 8 | D6 | T | |
| T21 | PR53B | 8 | D7/SPID0 | C | PR72B | 8 | D7/SPID0 | C | |
| VCCIO | VCCIO8 | 8 | | | VCCIO | 8 | | | |
| T22 | PR53A | 8 | DI/CSSPION | T | PR72A | 8 | DI/CSSPION | T | |
| R18 | PR52B | 8 | DOUT/CSON | C | PR71B | 8 | DOUT/CSON | C | |
| R19 | PR52A | 8 | BUSY/SISPI | T | PR71A | 8 | BUSY/SISPI | T | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| VCCIO | VCCIO3 | 3 | | | VCCIO | 3 | | | |
| R22 | PR47B | 3 | RDQ48 | C | PR66B | 3 | RDQ67 | C | |
| R21 | PR47A | 3 | RDQ48 | T | PR66A | 3 | RDQ67 | T | |
| P18 | PR46B | 3 | RDQ48 | C (LVDS)* | PR65B | 3 | RDQ67 | C (LVDS)* | |
| P19 | PR46A | 3 | RDQ48 | T (LVDS)* | PR65A | 3 | RDQ67 | T (LVDS)* | |
| VCCIO | VCCIO3 | 3 | | | VCCIO | 3 | | | |
| R20 | PR45B | 3 | RLM0_GPLL_C_FB_A/RDQ48 | C | PR64B | 3 | RLM0_GPLL_C_FB_A/RDQ67 | C | |
| P22 | PR45A | 3 | RLM0_GPLLT_FB_A/RDQ48 | T | PR64A | 3 | RLM0_GPLLT_FB_A/RDQ67 | T | |
| P21 | PR44B | 3 | RLM0_GPLL_C_IN_A**/RDQ48 | C (LVDS)* | PR63B | 3 | RLM0_GPLL_C_IN_A**/RDQ67 | C (LVDS)* | |
| N21 | PR44A | 3 | RLM0_GPLLT_IN_A**/RDQ48 | T (LVDS)* | PR63A | 3 | RLM0_GPLLT_IN_A**/RDQ67 | T (LVDS)* | |
| N17 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | | |
| N22 | PR42B | 3 | RLM0_GDLL_C_FB_A/RDQ39 | C | PR61B | 3 | RLM0_GDLL_C_FB_A/RDQ58 | C | |
| N20 | PR42A | 3 | RLM0_GDLLT_FB_A/RDQ39 | T | PR61A | 3 | RLM0_GDLLT_FB_A/RDQ58 | T | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| M22 | PR41B | 3 | RLM0_GDLL_C_IN_A**/RDQ39 | C (LVDS)* | PR60B | 3 | RLM0_GDLL_C_IN_A**/RDQ58 | C (LVDS)* | |
| M21 | PR41A | 3 | RLM0_GDLLT_IN_A**/RDQ39 | T (LVDS)* | PR60A | 3 | RLM0_GDLLT_IN_A**/RDQ58 | T (LVDS)* | |
| N19 | PR40B | 3 | RDQ39 | C | PR59B | 3 | RDQ58 | C | |
| M19 | PR40A | 3 | RDQ39 | T | PR59A | 3 | RDQ58 | T | |
| VCCIO | VCCIO3 | 3 | | | VCCIO | 3 | | | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| L22 | PR30B | 3 | RDQ31 | C | PR49B | 3 | RDQ50 | C | |
| K22 | PR30A | 3 | RDQ31 | T | PR49A | 3 | RDQ50 | T | |
| J22 | PR29B | 3 | RDQ31 | C (LVDS)* | PR48B | 3 | RDQ50 | C (LVDS)* | |
| H22 | PR29A | 3 | RDQ31 | T (LVDS)* | PR48A | 3 | RDQ50 | T (LVDS)* | |
| VCCIO | VCCIO3 | 3 | | | VCCIO | 3 | | | |
| M20 | PR28B | 3 | VREF2_3/RDQ31 | C | PR47B | 3 | VREF2_3/RDQ50 | C | |
| L21 | PR28A | 3 | VREF1_3/RDQ31 | T | PR47A | 3 | VREF1_3/RDQ50 | T | |
| K21 | PR27B | 3 | PCLKC3_0/RDQ31 | C (LVDS)* | PR46B | 3 | PCLKC3_0/RDQ50 | C (LVDS)* | |
| J21 | PR27A | 3 | PCLKT3_0/RDQ31 | T (LVDS)* | PR46A | 3 | PCLKT3_0/RDQ50 | T (LVDS)* | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| M18 | PR25B | 2 | PCLKC2_0/RDQ22 | C | PR44B | 2 | PCLKC2_0/RDQ41 | C |
| L17 | PR25A | 2 | PCLKT2_0/RDQ22 | T | PR44A | 2 | PCLKT2_0/RDQ41 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| L19 | PR24B | 2 | RDQ22 | C (LVDS)* | PR43B | 2 | RDQ41 | C (LVDS)* |
| L20 | PR24A | 2 | RDQ22 | T (LVDS)* | PR43A | 2 | RDQ41 | T (LVDS)* |
| L18 | PR23B | 2 | RDQ22 | C | PR42B | 2 | RDQ41 | C |
| K17 | PR23A | 2 | RDQ22 | T | PR42A | 2 | RDQ41 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO | 2 | | |
| K18 | PR22B | 2 | RDQ22 | C (LVDS)* | PR41B | 2 | RDQ41 | C (LVDS)* |
| K19 | PR22A | 2 | RDQS22 | T (LVDS)* | PR41A | 2 | RDQS41 | T (LVDS)* |
| G22 | PR21B | 2 | RDQ22 | C | PR40B | 2 | RDQ41 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| F22 | PR21A | 2 | RDQ22 | T | PR40A | 2 | RDQ41 | T |
| J17 | PR20B | 2 | RDQ22 | C (LVDS)* | PR39B | 2 | RDQ41 | C (LVDS)* |
| J18 | PR20A | 2 | RDQ22 | T (LVDS)* | PR39A | 2 | RDQ41 | T (LVDS)* |
| K20 | PR19B | 2 | RDQ22 | C | PR38B | 2 | RDQ41 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO | 2 | | |
| J19 | PR19A | 2 | RDQ22 | T | PR38A | 2 | RDQ41 | T |
| H21 | PR18B | 2 | RDQ22 | C (LVDS)* | PR37B | 2 | RDQ41 | C (LVDS)* |
| G21 | PR18A | 2 | RDQ22 | T (LVDS)* | PR37A | 2 | RDQ41 | T (LVDS)* |
| - | - | - | | | GNDIO2 | - | | |
| - | - | - | | | VCCIO | 2 | | |
| H17 | NC | - | | | PR26B | 2 | RUM0_SPLLC_FB_A/RDQ24 | C |
| H16 | NC | - | | | PR26A | 2 | RUM0_SPLLT_FB_A/RDQ24 | T |
| H20 | NC | - | | | PR25B | 2 | RUM0_SPLLC_IN_A/RDQ24 | C |
| H18 | NC | - | | | PR25A | 2 | RUM0_SPLLT_IN_A/RDQ24 | T |
| - | - | - | | | GNDIO2 | - | | |
| - | - | - | | | VCCIO | 2 | | |
| F21 | PR17B | 2 | RDQ14 | C | PR19B | 2 | RDQ16 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| E22 | PR17A | 2 | RDQ14 | T | PR19A | 2 | RDQ16 | T |
| D22 | PR16B | 2 | RDQ14 | C (LVDS)* | PR18B | 2 | RDQ16 | C (LVDS)* |
| E21 | PR16A | 2 | RDQ14 | T (LVDS)* | PR18A | 2 | RDQ16 | T (LVDS)* |
| G20 | PR15B | 2 | RDQ14 | C | PR17B | 2 | RDQ16 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO | 2 | | |
| F20 | PR15A | 2 | RDQ14 | T | PR17A | 2 | RDQ16 | T |
| H19 | PR14B | 2 | RDQ14 | C (LVDS)* | PR16B | 2 | RDQ16 | C (LVDS)* |
| G19 | PR14A | 2 | RDQS14 | T (LVDS)* | PR16A | 2 | RDQS16 | T (LVDS)* |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| G17 | PR13B | 2 | RDQ14 | C | PR15B | 2 | RDQ16 | C |
| F19 | PR13A | 2 | RDQ14 | T | PR15A | 2 | RDQ16 | T |
| E20 | PR12B | 2 | RDQ14 | C (LVDS)* | PR14B | 2 | RDQ16 | C (LVDS)* |
| D20 | PR12A | 2 | RDQ14 | T (LVDS)* | PR14A | 2 | RDQ16 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO | 2 | | |
| F18 | PR11B | 2 | RDQ14 | C | PR13B | 2 | RDQ16 | C |
| F16 | PR11A | 2 | RDQ14 | T | PR13A | 2 | RDQ16 | T |
| C21 | PR10B | 2 | RDQ14 | C (LVDS)* | PR12B | 2 | RDQ16 | C (LVDS)* |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| C22 | PR10A | 2 | RDQ14 | T (LVDS)* | PR12A | 2 | RDQ16 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO | 2 | | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| D19 | PR2B | 2 | VREF2_2/RDQ6 | C (LVDS)* | PR2B | 2 | VREF2_2 | C (LVDS)* |
| E19 | PR2A | 2 | VREF1_2/RDQ6 | T (LVDS)* | PR2A | 2 | VREF1_2 | T (LVDS)* |
| B21 | PT73B | 1 | VREF2_1 | C | PT82B | 1 | VREF2_1 | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| B22 | PT73A | 1 | VREF1_1 | T | PT82A | 1 | VREF1_1 | T |
| C20 | PT72B | 1 | | C | PT81B | 1 | | C |
| C19 | PT72A | 1 | | T | PT81A | 1 | | T |
| D18 | PT71B | 1 | | C | PT80B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| E18 | PT71A | 1 | | T | PT80A | 1 | | T |
| B20 | PT70B | 1 | | C | PT79B | 1 | | C |
| A19 | PT70A | 1 | | T | PT79A | 1 | | T |
| D17 | PT69B | 1 | | C | PT78B | 1 | | C |
| C18 | PT69A | 1 | | T | PT78A | 1 | | T |
| A21 | PT68B | 1 | | C | PT77B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| A20 | PT68A | 1 | | T | PT77A | 1 | | T |
| A18 | PT67B | 1 | | C | PT76B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| B18 | PT67A | 1 | | T | PT76A | 1 | | T |
| G16 | PT66B | 1 | | C | PT75B | 1 | | C |
| G15 | PT66A | 1 | | T | PT75A | 1 | | T |
| D16 | PT65B | 1 | | C | PT74B | 1 | | C |
| E16 | PT65A | 1 | | T | PT74A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| C17 | PT55B | 1 | | C | PT64B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| C16 | PT55A | 1 | | T | PT64A | 1 | | T |
| B17 | PT54B | 1 | | C | PT63B | 1 | | C |
| B16 | PT54A | 1 | | T | PT63A | 1 | | T |
| A17 | PT53B | 1 | | C | PT62B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| A16 | PT53A | 1 | | T | PT62A | 1 | | T |
| C15 | PT52B | 1 | | C | PT61B | 1 | | C |
| D15 | PT52A | 1 | | T | PT61A | 1 | | T |
| E15 | PT51B | 1 | | C | PT60B | 1 | | C |
| F15 | PT51A | 1 | | T | PT60A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| B15 | PT49B | 1 | | C | PT58B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| A15 | PT49A | 1 | | T | PT58A | 1 | | T |
| B14 | PT48B | 1 | | C | PT57B | 1 | | C |
| A14 | PT48A | 1 | | T | PT57A | 1 | | T |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D14 | PT46B | 1 | | C | PT55B | 1 | | C |
| C13 | PT46A | 1 | | T | PT55A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| E14 | PT45B | 1 | | C | PT54B | 1 | | C |
| F14 | PT45A | 1 | | T | PT54A | 1 | | T |
| A13 | PT44B | 1 | | C | PT53B | 1 | | C |
| B13 | PT44A | 1 | | T | PT53A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| E13 | PT43B | 1 | | C | PT52B | 1 | | C |
| D13 | PT43A | 1 | | T | PT52A | 1 | | T |
| E12 | PT42B | 1 | | C | PT51B | 1 | | C |
| D12 | PT42A | 1 | | T | PT51A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| A12 | PT40B | 1 | | C | PT49B | 1 | | C |
| A11 | PT40A | 1 | | T | PT49A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO | 1 | | |
| B12 | PT39B | 1 | PCLKC1_0 | C | PT48B | 1 | PCLKC1_0 | C |
| C12 | PT39A | 1 | PCLKT1_0 | T | PT48A | 1 | PCLKT1_0 | T |
| F12 | XRES | 1 | | | XRES | 1 | | |
| B10 | PT37B | 0 | PCLKC0_0 | C | PT46B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| B11 | PT37A | 0 | PCLKT0_0 | T | PT46A | 0 | PCLKT0_0 | T |
| A10 | PT36B | 0 | | C | PT45B | 0 | | C |
| A9 | PT36A | 0 | | T | PT45A | 0 | | T |
| C11 | PT35B | 0 | | C | PT44B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| C10 | PT35A | 0 | | T | PT44A | 0 | | T |
| E11 | PT34B | 0 | | C | PT43B | 0 | | C |
| F11 | PT34A | 0 | | T | PT43A | 0 | | T |
| A8 | PT33B | 0 | | C | PT42B | 0 | | C |
| A7 | PT33A | 0 | | T | PT42A | 0 | | T |
| B8 | PT32B | 0 | | C | PT41B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| B9 | PT32A | 0 | | T | PT41A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| B7 | PT30B | 0 | | C | PT39B | 0 | | C |
| A6 | PT30A | 0 | | T | PT39A | 0 | | T |
| C8 | PT29B | 0 | | C | PT38B | 0 | | C |
| D8 | PT29A | 0 | | T | PT38A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| D10 | PT27B | 0 | | C | PT36B | 0 | | C |
| E10 | PT27A | 0 | | T | PT36A | 0 | | T |
| C7 | PT26B | 0 | | C | PT35B | 0 | | C |
| C6 | PT26A | 0 | | T | PT35A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| B6 | PT25B | 0 | | C | PT34B | 0 | | C |
| B5 | PT25A | 0 | | T | PT34A | 0 | | T |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F10 | PT24B | 0 | | C | PT33B | 0 | | C |
| D9 | PT24A | 0 | | T | PT33A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| F9 | PT23B | 0 | | C | PT32B | 0 | | C |
| E9 | PT23A | 0 | | T | PT32A | 0 | | T |
| A5 | PT22B | 0 | | C | PT31B | 0 | | C |
| A4 | PT22A | 0 | | T | PT31A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| A3 | PT21B | 0 | | C | PT30B | 0 | | C |
| A2 | PT21A | 0 | | T | PT30A | 0 | | T |
| G8 | PT20B | 0 | | C | PT29B | 0 | | C |
| E8 | PT20A | 0 | | T | PT29A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| C3 | PT10B | 0 | | C | PT10B | 0 | | C |
| B3 | PT10A | 0 | | T | PT10A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| F8 | PT9B | 0 | | C | PT9B | 0 | | C |
| D7 | PT9A | 0 | | T | PT9A | 0 | | T |
| E7 | PT8B | 0 | | C | PT8B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| F7 | PT8A | 0 | | T | PT8A | 0 | | T |
| D5 | PT7B | 0 | | C | PT7B | 0 | | C |
| D6 | PT7A | 0 | | T | PT7A | 0 | | T |
| D4 | PT6B | 0 | | C | PT6B | 0 | | C |
| C4 | PT6A | 0 | | T | PT6A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | 0 | | |
| B2 | PT5B | 0 | | C | PT5B | 0 | | C |
| B1 | PT5A | 0 | | T | PT5A | 0 | | T |
| J7 | PT4B | 0 | | C | PT4B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO | 0 | | |
| H7 | PT4A | 0 | | T | PT4A | 0 | | T |
| D3 | PT3B | 0 | | C | PT3B | 0 | | C |
| C2 | PT3A | 0 | | T | PT3A | 0 | | T |
| D1 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| C1 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |
| J10 | VCC | - | | | VCC | - | | |
| J11 | VCC | - | | | VCC | - | | |
| J12 | VCC | - | | | VCC | - | | |
| J13 | VCC | - | | | VCC | - | | |
| K14 | VCC | - | | | VCC | - | | |
| K9 | VCC | - | | | VCC | - | | |
| L14 | VCC | - | | | VCC | - | | |
| L9 | VCC | - | | | VCC | - | | |
| M14 | VCC | - | | | VCC | - | | |
| M9 | VCC | - | | | VCC | - | | |
| N14 | VCC | - | | | VCC | - | | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| N9 | VCC | - | | | VCC | - | | |
| P10 | VCC | - | | | VCC | - | | |
| P11 | VCC | - | | | VCC | - | | |
| P12 | VCC | - | | | VCC | - | | |
| P13 | VCC | - | | | VCC | - | | |
| G5 | VCCAUX | - | | | VCCAUX | 0 | | |
| K5 | VCCAUX | - | | | VCCAUX | 0 | | |
| R5 | VCCAUX | - | | | VCCAUX | 1 | | |
| V7 | VCCAUX | - | | | VCCAUX | 1 | | |
| V11 | VCCAUX | - | | | VCCAUX | 2 | | |
| V8 | VCCAUX | - | | | VCCAUX | 2 | | |
| V13 | VCCAUX | - | | | VCCAUX | 3 | | |
| V15 | VCCAUX | - | | | VCCAUX | 3 | | |
| M17 | VCCAUX | - | | | VCCAUX | 4 | | |
| P17 | VCCAUX | - | | | VCCAUX | 4 | | |
| E17 | VCCAUX | - | | | VCCAUX | 5 | | |
| G18 | VCCAUX | - | | | VCCAUX | 5 | | |
| D11 | VCCAUX | - | | | VCCAUX | 6 | | |
| F13 | VCCAUX | - | | | VCCAUX | 6 | | |
| C5 | VCCAUX | - | | | VCCAUX | 7 | | |
| E6 | VCCAUX | - | | | VCCAUX | 7 | | |
| G10 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H8 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G11 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G12 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G13 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G14 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H14 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H15 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J15 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K16 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| M16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| N16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| P16 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R14 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| T12 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| T13 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| T14 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| R9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T10 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T11 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| T9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| N7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| P7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| P8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| J8 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| P15 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| R15 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| A22 | GND | - | | | GND | - | | |
| AA19 | GND | - | | | GND | - | | |
| AA4 | GND | - | | | GND | - | | |
| AB1 | GND | - | | | GND | - | | |
| AB22 | GND | - | | | GND | - | | |
| B19 | GND | - | | | GND | - | | |
| B4 | GND | - | | | GND | - | | |
| C14 | GND | - | | | GND | - | | |
| C9 | GND | - | | | GND | - | | |
| D2 | GND | - | | | GND | - | | |
| D21 | GND | - | | | GND | - | | |
| F17 | GND | - | | | GND | - | | |
| F6 | GND | - | | | GND | - | | |
| H10 | GND | - | | | GND | - | | |
| H11 | GND | - | | | GND | - | | |
| H12 | GND | - | | | GND | - | | |
| H13 | GND | - | | | GND | - | | |
| J14 | GND | - | | | GND | - | | |
| J20 | GND | - | | | GND | - | | |
| J3 | GND | - | | | GND | - | | |
| J9 | GND | - | | | GND | - | | |
| K10 | GND | - | | | GND | - | | |
| K11 | GND | - | | | GND | - | | |
| K12 | GND | - | | | GND | - | | |
| K13 | GND | - | | | GND | - | | |
| K15 | GND | - | | | GND | - | | |
| K8 | GND | - | | | GND | - | | |
| L10 | GND | - | | | GND | - | | |
| L11 | GND | - | | | GND | - | | |
| L12 | GND | - | | | GND | - | | |
| L13 | GND | - | | | GND | - | | |
| L15 | GND | - | | | GND | - | | |
| L8 | GND | - | | | GND | - | | |
| M10 | GND | - | | | GND | - | | |
| M11 | GND | - | | | GND | - | | |
| M12 | GND | - | | | GND | - | | |
| M13 | GND | - | | | GND | - | | |
| M15 | GND | - | | | GND | - | | |
| M8 | GND | - | | | GND | - | | |

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA

| LFE2-35E/SE | | | | | LFE2-50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| N10 | GND | - | | | GND | - | | |
| N11 | GND | - | | | GND | - | | |
| N12 | GND | - | | | GND | - | | |
| N13 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N8 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P20 | GND | - | | | GND | - | | |
| P3 | GND | - | | | GND | - | | |
| P9 | GND | - | | | GND | - | | |
| R10 | GND | - | | | GND | - | | |
| R11 | GND | - | | | GND | - | | |
| R12 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| U17 | GND | - | | | GND | - | | |
| U6 | GND | - | | | GND | - | | |
| W2 | GND | - | | | GND | - | | |
| W21 | GND | - | | | GND | - | | |
| Y14 | GND | - | | | GND | - | | |
| Y9 | GND | - | | | GND | - | | |
| A1 | GND | - | | | GND | - | | |
| N18 | VCCPLL | - | | | VCCPLL | - | | |
| K6 | NC | - | | | VCCPLL | - | | |
| N6 | VCCPLL | - | | | VCCPLL | - | | |
| J16 | NC | - | | | VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D2 | PL2A | 7 | VREF2_7 | T (LVDS)* | PL2A | 7 | VREF2_7/LDQ6 | T (LVDS)* |
| D1 | PL2B | 7 | VREF1_7 | C (LVDS)* | PL2B | 7 | VREF1_7/LDQ6 | C (LVDS)* |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| F6 | PL3A | 7 | | T | PL3A | 7 | LDQ6 | T |
| F5 | PL3B | 7 | | C | PL3B | 7 | LDQ6 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| E4 | NC | - | | | PL4A | 7 | LDQ6 | T (LVDS)* |
| E3 | NC | - | | | PL4B | 7 | LDQ6 | C (LVDS)* |
| E2 | NC | - | | | PL5A | 7 | LDQ6 | T |
| E1 | NC | - | | | PL5B | 7 | LDQ6 | C |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| H6 | NC | - | | | PL6A | 7 | LDQS6 | T (LVDS)* |
| H5 | NC | - | | | PL6B | 7 | LDQ6 | C (LVDS)* |
| F2 | NC | - | | | PL7A | 7 | LDQ6 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| F1 | NC | - | | | PL7B | 7 | LDQ6 | C |
| H8 | NC | - | | | PL8A | 7 | LDQ6 | T (LVDS)* |
| J9 | NC | - | | | PL8B | 7 | LDQ6 | C (LVDS)* |
| G4 | NC | - | | | PL9A | 7 | LDQ6 | T |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| G3 | NC | - | | | PL9B | 7 | LDQ6 | C |
| H7 | PL4A | 7 | LDQ8 | T (LVDS)* | PL10A | 7 | LDQ14 | T (LVDS)* |
| J8 | PL4B | 7 | LDQ8 | C (LVDS)* | PL10B | 7 | LDQ14 | C (LVDS)* |
| G2 | PL5A | 7 | LDQ8 | T | PL11A | 7 | LDQ14 | T |
| G1 | PL5B | 7 | LDQ8 | C | PL11B | 7 | LDQ14 | C |
| H3 | PL6A | 7 | LDQ8 | T (LVDS)* | PL12A | 7 | LDQ14 | T (LVDS)* |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| H4 | PL6B | 7 | LDQ8 | C (LVDS)* | PL12B | 7 | LDQ14 | C (LVDS)* |
| J5 | PL7A | 7 | LDQ8 | T | PL13A | 7 | LDQ14 | T |
| J4 | PL7B | 7 | LDQ8 | C | PL13B | 7 | LDQ14 | C |
| J3 | PL8A | 7 | LDQS8 | T (LVDS)* | PL14A | 7 | LDQS14 | T (LVDS)* |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| K4 | PL8B | 7 | LDQ8 | C (LVDS)* | PL14B | 7 | LDQ14 | C (LVDS)* |
| H1 | PL9A | 7 | LDQ8 | T | PL15A | 7 | LDQ14 | T |
| H2 | PL9B | 7 | LDQ8 | C | PL15B | 7 | LDQ14 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K6 | PL10A | 7 | LDQ8 | T (LVDS)* | PL16A | 7 | LDQ14 | T (LVDS)* |
| K7 | PL10B | 7 | LDQ8 | C (LVDS)* | PL16B | 7 | LDQ14 | C (LVDS)* |
| J1 | PL11A | 7 | LDQ8 | T | PL17A | 7 | LDQ14 | T |
| J2 | PL11B | 7 | LDQ8 | C | PL17B | 7 | LDQ14 | C |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K3 | NC | - | | | NC | - | | |
| K2 | NC | - | | | NC | - | | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| K1 | NC | - | | | NC | - | | |
| L2 | NC | - | | | NC | - | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| L1 | NC | - | | | NC | - | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M2 | NC | - | | | NC | - | | |
| M1 | NC | - | | | NC | - | | |
| N2 | NC | - | | | NC | - | | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| M8 | VCC | - | | | NC | - | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| N1 | PL12A | 7 | LDQ16 | | PL18A | 7 | LDQ22 | |
| L8 | PL13A | 7 | LDQ16 | T | PL19A | 7 | LDQ22 | T |
| K8 | PL13B | 7 | LDQ16 | C | PL19B | 7 | LDQ22 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L6 | PL14A | 7 | LDQ16 | T (LVDS)* | PL20A | 7 | LDQ22 | T (LVDS)* |
| K5 | PL14B | 7 | LDQ16 | C (LVDS)* | PL20B | 7 | LDQ22 | C (LVDS)* |
| L7 | PL15A | 7 | LDQ16 | T | PL21A | 7 | LDQ22 | T |
| L5 | PL15B | 7 | LDQ16 | C | PL21B | 7 | LDQ22 | C |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| P1 | PL16A | 7 | LDQS16 | T (LVDS)* | PL22A | 7 | LDQS22 | T (LVDS)* |
| P2 | PL16B | 7 | LDQ16 | C (LVDS)* | PL22B | 7 | LDQ22 | C (LVDS)* |
| M6 | PL17A | 7 | LDQ16 | T | PL23A | 7 | LDQ22 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| N8 | PL17B | 7 | LDQ16 | C | PL23B | 7 | LDQ22 | C |
| R1 | PL18A | 7 | LDQ16 | T (LVDS)* | PL24A | 7 | LDQ22 | T (LVDS)* |
| R2 | PL18B | 7 | LDQ16 | C (LVDS)* | PL24B | 7 | LDQ22 | C (LVDS)* |
| M7 | PL19A | 7 | PCLKT7_0/LDQ16 | T | PL25A | 7 | PCLKT7_0/LDQ22 | T |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| N9 | PL19B | 7 | PCLKC7_0/LDQ16 | C | PL25B | 7 | PCLKC7_0/LDQ22 | C |
| M4 | PL21A | 6 | PCLKT6_0/LDQ25 | T (LVDS)* | PL27A | 6 | PCLKT6_0/LDQ31 | T (LVDS)* |
| M5 | PL21B | 6 | PCLKC6_0/LDQ25 | C (LVDS)* | PL27B | 6 | PCLKC6_0/LDQ31 | C (LVDS)* |
| N7 | PL22A | 6 | VREF2_6/LDQ25 | T | PL28A | 6 | VREF2_6/LDQ31 | T |
| P9 | PL22B | 6 | VREF1_6/LDQ25 | C | PL28B | 6 | VREF1_6/LDQ31 | C |
| N3 | PL23A | 6 | LDQ25 | T (LVDS)* | PL29A | 6 | LDQ31 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| N4 | PL23B | 6 | LDQ25 | C (LVDS)* | PL29B | 6 | LDQ31 | C (LVDS)* |
| N5 | PL24A | 6 | LDQ25 | T | PL30A | 6 | LDQ31 | T |
| P7 | PL24B | 6 | LDQ25 | C | PL30B | 6 | LDQ31 | C |
| T1 | NC | - | | | PL31A | 6 | LDQS31 | T (LVDS)* |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| T2 | NC | - | | | PL31B | 6 | LDQ31 | C (LVDS)* |
| P8 | NC | - | | | PL32A | 6 | LDQ31 | T |
| P6 | NC | - | | | PL32B | 6 | LDQ31 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| P5 | NC | - | | | PL33A | 6 | LDQ31 | T (LVDS)* |
| P4 | NC | - | | | PL33B | 6 | LDQ31 | C (LVDS)* |
| U1 | NC | - | | | PL34A | 6 | LDQ31 | T |
| V1 | NC | - | | | PL34B | 6 | LDQ31 | C |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|-------------------------|--------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| P3 | NC | - | | | NC | - | | |
| R3 | NC | - | | | NC | - | | |
| R4 | NC | - | | | NC | - | | |
| U2 | NC | - | | | NC | - | | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V2 | NC | - | | | NC | - | | |
| W2 | NC | - | | | NC | - | | |
| T6 | NC | - | | | PL38A | 6 | LDQ39 | T |
| R5 | NC | - | | | PL38B | 6 | LDQ39 | C |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| R6 | PL25A | 6 | LDQS25*** | T (LVDS)* | PL39A | 6 | LDQS39*** | T (LVDS)* |
| R7 | PL25B | 6 | LDQ25 | C (LVDS)* | PL39B | 6 | LDQ39 | C (LVDS)* |
| W1 | PL26A | 6 | LDQ25 | T | PL40A | 6 | LDQ39 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y2 | PL26B | 6 | LDQ25 | C | PL40B | 6 | LDQ39 | C |
| Y1 | PL27A | 6 | LLM0_GDLLT_IN_A**/LDQ25 | T (LVDS)* | PL41A | 6 | LLM0_GDLLT_IN_A**/LDQ39 | T (LVDS)* |
| AA2 | PL27B | 6 | LLM0_GDLLC_IN_A**/LDQ25 | C (LVDS)* | PL41B | 6 | LLM0_GDLLC_IN_A**/LDQ39 | C (LVDS)* |
| T5 | PL28A | 6 | LLM0_GDLLT_FB_A/LDQ25 | T | PL42A | 6 | LLM0_GDLLT_FB_A/LDQ39 | T |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| T7 | PL28B | 6 | LLM0_GDLLC_FB_A/LDQ25 | C | PL42B | 6 | LLM0_GDLLC_FB_A/LDQ39 | C |
| R8 | VCC | 6 | | | VCCPLL | 6 | | |
| T8 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | |
| U3 | PL30A | 6 | LLM0_GPLLT_IN_A**/LDQ34 | T (LVDS)* | PL44A | 6 | LLM0_GPLLT_IN_A**/LDQ48 | T (LVDS)* |
| U4 | PL30B | 6 | LLM0_GPLLC_IN_A**/LDQ34 | C (LVDS)* | PL44B | 6 | LLM0_GPLLC_IN_A**/LDQ48 | C (LVDS)* |
| V3 | PL31A | 6 | LLM0_GPLLT_FB_A/LDQ34 | T | PL45A | 6 | LLM0_GPLLT_FB_A/LDQ48 | T |
| U5 | PL31B | 6 | LLM0_GPLLC_FB_A/LDQ34 | C | PL45B | 6 | LLM0_GPLLC_FB_A/LDQ48 | C |
| V4 | PL32A | 6 | LDQ34 | T (LVDS)* | PL46A | 6 | LDQ48 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V5 | PL32B | 6 | LDQ34 | C (LVDS)* | PL46B | 6 | LDQ48 | C (LVDS)* |
| Y3 | PL33A | 6 | LDQ34 | T | PL47A | 6 | LDQ48 | T |
| Y4 | PL33B | 6 | LDQ34 | C | PL47B | 6 | LDQ48 | C |
| W3 | PL34A | 6 | LDQS34 | T (LVDS)* | PL48A | 6 | LDQS48 | T (LVDS)* |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| W4 | PL34B | 6 | LDQ34 | C (LVDS)* | PL48B | 6 | LDQ48 | C (LVDS)* |
| AA1 | PL35A | 6 | LDQ34 | T | PL49A | 6 | LDQ48 | T |
| AB1 | PL35B | 6 | LDQ34 | C | PL49B | 6 | LDQ48 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| U8 | PL36A | 6 | LDQ34 | T (LVDS)* | PL50A | 6 | LDQ48 | T (LVDS)* |
| U7 | PL36B | 6 | LDQ34 | C (LVDS)* | PL50B | 6 | LDQ48 | C (LVDS)* |
| V8 | PL37A | 6 | LDQ34 | T | PL51A | 6 | LDQ48 | T |
| U6 | PL37B | 6 | LDQ34 | C | PL51B | 6 | LDQ48 | C |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| W6 | PL38A | 6 | LDQ42 | T (LVDS)* | PL52A | 6 | LDQ56 | T (LVDS)* |
| W5 | PL38B | 6 | LDQ42 | C (LVDS)* | PL52B | 6 | LDQ56 | C (LVDS)* |
| AC1 | PL39A | 6 | LDQ42 | T | PL53A | 6 | LDQ56 | T |
| AD1 | PL39B | 6 | LDQ42 | C | PL53B | 6 | LDQ56 | C |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y6 | PL40A | 6 | LDQ42 | T (LVDS)* | PL54A | 6 | LDQ56 | T (LVDS)* |
| Y5 | PL40B | 6 | LDQ42 | C (LVDS)* | PL54B | 6 | LDQ56 | C (LVDS)* |
| AE2 | PL41A | 6 | LDQ42 | T | PL55A | 6 | LDQ56 | T |
| AD2 | PL41B | 6 | LDQ42 | C | PL55B | 6 | LDQ56 | C |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| AB3 | PL42A | 6 | LDQS42 | T (LVDS)* | PL56A | 6 | LDQS56 | T (LVDS)* |
| AB2 | PL42B | 6 | LDQ42 | C (LVDS)* | PL56B | 6 | LDQ56 | C (LVDS)* |
| W7 | PL43A | 6 | LDQ42 | T | PL57A | 6 | LDQ56 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W8 | PL43B | 6 | LDQ42 | C | PL57B | 6 | LDQ56 | C |
| Y7 | PL44A | 6 | LDQ42 | T (LVDS)* | PL58A | 6 | LDQ56 | T (LVDS)* |
| Y8 | PL44B | 6 | LDQ42 | C (LVDS)* | PL58B | 6 | LDQ56 | C (LVDS)* |
| AC2 | PL45A | 6 | LDQ42 | T | PL59A | 6 | LDQ56 | T |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| AD3 | PL45B | 6 | LDQ42 | C | PL59B | 6 | LDQ56 | C |
| AC3 | TCK | - | | | TCK | - | | |
| AA8 | TDI | - | | | TDI | - | | |
| AB4 | TMS | - | | | TMS | - | | |
| AA5 | TDO | - | | | TDO | - | | |
| AB5 | VCCJ | - | | | VCCJ | - | | |
| AE3 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T |
| AF3 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C |
| AC4 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T |
| AD4 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C |
| AE4 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T |
| AF4 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| V9 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T |
| W9 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C |
| GND | GNDIO5 | - | | | GNDIO5 | - | | |
| AA6 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T |
| AB6 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C |
| AC5 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T |
| AD5 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C |
| AA7 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T |
| AB7 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AE5 | PB9A | 5 | BDQ6 | T | PB9A | 5 | BDQ6 | T |
| AF5 | PB9B | 5 | BDQ6 | C | PB9B | 5 | BDQ6 | C |
| AC7 | PB10A | 5 | BDQ6 | T | PB10A | 5 | BDQ6 | T |
| AD7 | PB10B | 5 | BDQ6 | C | PB10B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | |
| W10 | PB11A | 5 | BDQ15 | T | PB11A | 5 | BDQ15 | T |
| Y10 | PB11B | 5 | BDQ15 | C | PB11B | 5 | BDQ15 | C |
| W11 | PB12A | 5 | BDQ15 | T | PB12A | 5 | BDQ15 | T |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AA10 | PB12B | 5 | BDQ15 | C | PB12B | 5 | BDQ15 | C | |
| AC8 | PB13A | 5 | BDQ15 | T | PB13A | 5 | BDQ15 | T | |
| AD8 | PB13B | 5 | BDQ15 | C | PB13B | 5 | BDQ15 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AB8 | PB14A | 5 | BDQ15 | T | PB14A | 5 | BDQ15 | T | |
| AB10 | PB14B | 5 | BDQ15 | C | PB14B | 5 | BDQ15 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AE6 | PB15A | 5 | BDQS15 | T | PB15A | 5 | BDQS15 | T | |
| AF6 | PB15B | 5 | BDQ15 | C | PB15B | 5 | BDQ15 | C | |
| AA11 | PB16A | 5 | BDQ15 | T | PB16A | 5 | BDQ15 | T | |
| AC9 | PB16B | 5 | BDQ15 | C | PB16B | 5 | BDQ15 | C | |
| AB9 | PB17A | 5 | BDQ15 | T | PB17A | 5 | BDQ15 | T | |
| AD9 | PB17B | 5 | BDQ15 | C | PB17B | 5 | BDQ15 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y11 | PB18A | 5 | BDQ15 | T | PB18A | 5 | BDQ15 | T | |
| AB11 | PB18B | 5 | BDQ15 | C | PB18B | 5 | BDQ15 | C | |
| AE7 | PB19A | 5 | BDQ15 | T | PB19A | 5 | BDQ15 | T | |
| AF7 | PB19B | 5 | BDQ15 | C | PB19B | 5 | BDQ15 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AC10 | PB20A | 5 | BDQ24 | T | PB20A | 5 | BDQ24 | T | |
| AD10 | PB20B | 5 | BDQ24 | C | PB20B | 5 | BDQ24 | C | |
| AA12 | PB21A | 5 | BDQ24 | T | PB21A | 5 | BDQ24 | T | |
| W12 | PB21B | 5 | BDQ24 | C | PB21B | 5 | BDQ24 | C | |
| AB12 | PB22A | 5 | BDQ24 | T | PB22A | 5 | BDQ24 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y12 | PB22B | 5 | BDQ24 | C | PB22B | 5 | BDQ24 | C | |
| AD12 | PB23A | 5 | BDQ24 | T | PB23A | 5 | BDQ24 | T | |
| AC12 | PB23B | 5 | BDQ24 | C | PB23B | 5 | BDQ24 | C | |
| AC13 | PB24A | 5 | BDQS24 | T | PB24A | 5 | BDQS24 | T | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AA13 | PB24B | 5 | BDQ24 | C | PB24B | 5 | BDQ24 | C | |
| AD13 | PB25A | 5 | BDQ24 | T | PB25A | 5 | BDQ24 | T | |
| AC14 | PB25B | 5 | BDQ24 | C | PB25B | 5 | BDQ24 | C | |
| AE8 | PB26A | 5 | BDQ24 | T | PB26A | 5 | BDQ24 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AF8 | PB26B | 5 | BDQ24 | C | PB26B | 5 | BDQ24 | C | |
| AB15 | PB27A | 5 | BDQ24 | T | PB27A | 5 | BDQ24 | T | |
| Y13 | PB27B | 5 | BDQ24 | C | PB27B | 5 | BDQ24 | C | |
| AE9 | PB28A | 5 | BDQ24 | T | PB28A | 5 | BDQ24 | T | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AF9 | PB28B | 5 | BDQ24 | C | PB28B | 5 | BDQ24 | C | |
| W13 | PB29A | 5 | BDQ33 | T | PB29A | 5 | BDQ33 | T | |
| AA14 | PB29B | 5 | BDQ33 | C | PB29B | 5 | BDQ33 | C | |
| AE10 | PB30A | 5 | BDQ33 | T | PB30A | 5 | BDQ33 | T | |
| AF10 | PB30B | 5 | BDQ33 | C | PB30B | 5 | BDQ33 | C | |
| W14 | PB31A | 5 | BDQ33 | T | PB31A | 5 | BDQ33 | T | |
| AB13 | PB31B | 5 | BDQ33 | C | PB31B | 5 | BDQ33 | C | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | | |
|---------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y14 | PB32A | 5 | BDQ33 | T | PB32A | 5 | BDQ33 | T | |
| AB14 | PB32B | 5 | BDQ33 | C | PB32B | 5 | BDQ33 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AE11 | PB33A | 5 | BDQS33 | T | PB33A | 5 | BDQS33 | T | |
| AF11 | PB33B | 5 | BDQ33 | C | PB33B | 5 | BDQ33 | C | |
| AD14 | PB34A | 5 | BDQ33 | T | PB34A | 5 | BDQ33 | T | |
| AA15 | PB34B | 5 | BDQ33 | C | PB34B | 5 | BDQ33 | C | |
| AE12 | PB35A | 5 | PCLKT5_0/BDQ33 | T | PB35A | 5 | PCLKT5_0/BDQ33 | T | |
| AF12 | PB35B | 5 | PCLKC5_0/BDQ33 | C | PB35B | 5 | PCLKC5_0/BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AD15 | PB40A | 4 | PCLKT4_0/BDQ42 | T | PB40A | 4 | PCLKT4_0/BDQ42 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AC15 | PB40B | 4 | PCLKC4_0/BDQ42 | C | PB40B | 4 | PCLKC4_0/BDQ42 | C | |
| AE13 | PB41A | 4 | BDQ42 | T | PB41A | 4 | BDQ42 | T | |
| AF13 | PB41B | 4 | BDQ42 | C | PB41B | 4 | BDQ42 | C | |
| AB17 | PB42A | 4 | BDQS42 | T | PB42A | 4 | BDQS42 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| Y15 | PB42B | 4 | BDQ42 | C | PB42B | 4 | BDQ42 | C | |
| AE14 | PB43A | 4 | BDQ42 | T | PB43A | 4 | BDQ42 | T | |
| AF14 | PB43B | 4 | BDQ42 | C | PB43B | 4 | BDQ42 | C | |
| AA16 | PB44A | 4 | BDQ42 | T | PB44A | 4 | BDQ42 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| W15 | PB44B | 4 | BDQ42 | C | PB44B | 4 | BDQ42 | C | |
| AC17 | PB45A | 4 | BDQ42 | T | PB45A | 4 | BDQ42 | T | |
| AB16 | PB45B | 4 | BDQ42 | C | PB45B | 4 | BDQ42 | C | |
| AE15 | PB46A | 4 | BDQ42 | T | PB46A | 4 | BDQ42 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AF15 | PB46B | 4 | BDQ42 | C | PB46B | 4 | BDQ42 | C | |
| AE16 | PB47A | 4 | BDQ51 | T | PB47A | 4 | BDQ51 | T | |
| AF16 | PB47B | 4 | BDQ51 | C | PB47B | 4 | BDQ51 | C | |
| Y16 | PB48A | 4 | BDQ51 | T | PB48A | 4 | BDQ51 | T | |
| AB18 | PB48B | 4 | BDQ51 | C | PB48B | 4 | BDQ51 | C | |
| AD17 | PB49A | 4 | BDQ51 | T | PB49A | 4 | BDQ51 | T | |
| AD18 | PB49B | 4 | BDQ51 | C | PB49B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AC18 | PB50A | 4 | BDQ51 | T | PB50A | 4 | BDQ51 | T | |
| AD19 | PB50B | 4 | BDQ51 | C | PB50B | 4 | BDQ51 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AC19 | PB51A | 4 | BDQS51 | T | PB51A | 4 | BDQS51 | T | |
| AE17 | PB51B | 4 | BDQ51 | C | PB51B | 4 | BDQ51 | C | |
| AB19 | PB52A | 4 | BDQ51 | T | PB52A | 4 | BDQ51 | T | |
| AE19 | PB52B | 4 | BDQ51 | C | PB52B | 4 | BDQ51 | C | |
| AF17 | PB53A | 4 | BDQ51 | T | PB53A | 4 | BDQ51 | T | |
| AE18 | PB53B | 4 | BDQ51 | C | PB53B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| W16 | PB54A | 4 | BDQ51 | T | PB54A | 4 | BDQ51 | T | |
| AA17 | PB54B | 4 | BDQ51 | C | PB54B | 4 | BDQ51 | C | |
| AF18 | PB55A | 4 | BDQ51 | T | PB55A | 4 | BDQ51 | T | |
| AF19 | PB55B | 4 | BDQ51 | C | PB55B | 4 | BDQ51 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA19 | NC | - | | | PB56A | 4 | BDQ60 | T | |
| W17 | NC | - | | | PB56B | 4 | BDQ60 | C | |
| Y19 | NC | - | | | PB57A | 4 | BDQ60 | T | |
| Y17 | NC | - | | | PB57B | 4 | BDQ60 | C | |
| AF20 | NC | - | | | NC | - | | | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AE20 | NC | - | | | NC | - | | | |
| AA20 | NC | - | | | NC | - | | | |
| W18 | NC | - | | | NC | - | | | |
| AD20 | NC | - | | | NC | - | | | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AE21 | NC | - | | | NC | - | | | |
| AF21 | NC | - | | | NC | - | | | |
| AF22 | NC | - | | | NC | - | | | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AE22 | PB56A | 4 | BDQ60 | T | PB65A | 4 | BDQ69 | T | |
| AD22 | PB56B | 4 | BDQ60 | C | PB65B | 4 | BDQ69 | C | |
| AF23 | PB57A | 4 | BDQ60 | T | PB66A | 4 | BDQ69 | T | |
| AE23 | PB57B | 4 | BDQ60 | C | PB66B | 4 | BDQ69 | C | |
| AD23 | PB58A | 4 | BDQ60 | T | PB67A | 4 | BDQ69 | T | |
| AC23 | PB58B | 4 | BDQ60 | C | PB67B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AB20 | PB59A | 4 | BDQ60 | T | PB68A | 4 | BDQ69 | T | |
| AC20 | PB59B | 4 | BDQ60 | C | PB68B | 4 | BDQ69 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AB21 | PB60A | 4 | BDQS60 | T | PB69A | 4 | BDQS69 | T | |
| AC22 | PB60B | 4 | BDQ60 | C | PB69B | 4 | BDQ69 | C | |
| W19 | PB61A | 4 | BDQ60 | T | PB70A | 4 | BDQ69 | T | |
| AA21 | PB61B | 4 | BDQ60 | C | PB70B | 4 | BDQ69 | C | |
| AF24 | PB62A | 4 | BDQ60 | T | PB71A | 4 | BDQ69 | T | |
| AE24 | PB62B | 4 | BDQ60 | C | PB71B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| Y20 | PB63A | 4 | BDQ60 | T | PB72A | 4 | BDQ69 | T | |
| AB22 | PB63B | 4 | BDQ60 | C | PB72B | 4 | BDQ69 | C | |
| Y21 | PB64A | 4 | VREF2_4/BDQ60 | T | PB73A | 4 | VREF2_4/BDQ69 | T | |
| AB23 | PB64B | 4 | VREF1_4/BDQ60 | C | PB73B | 4 | VREF1_4/BDQ69 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AD24 | CFG2 | 8 | | | CFG2 | 8 | | | |
| W20 | CFG1 | 8 | | | CFG1 | 8 | | | |
| AC24 | CFG0 | 8 | | | CFG0 | 8 | | | |
| V19 | PROGRAMN | 8 | | | PROGRAMN | 8 | | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|--------------------------|--------------|-------------------|------|--------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AA22 | CCLK | 8 | | | CCLK | 8 | | |
| AB24 | INITN | 8 | | | INITN | 8 | | |
| AD25 | DONE | 8 | | | DONE | 8 | | |
| GND | GNDIO8 | - | | | GNDIO8 | - | | |
| W21 | PR44B | 8 | WRITEN | C | PR58B | 8 | WRITEN | C |
| Y22 | PR44A | 8 | CS1N | T | PR58A | 8 | CS1N | T |
| AC25 | PR43B | 8 | CSN | C | PR57B | 8 | CSN | C |
| AB25 | PR43A | 8 | D0/SPIFASTN | T | PR57A | 8 | D0/SPIFASTN | T |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AD26 | PR42B | 8 | D1 | C | PR56B | 8 | D1 | C |
| AC26 | PR42A | 8 | D2 | T | PR56A | 8 | D2 | T |
| Y23 | PR41B | 8 | D3 | C | PR55B | 8 | D3 | C |
| GND | GNDIO8 | - | | | GNDIO8 | - | | |
| W22 | PR41A | 8 | D4 | T | PR55A | 8 | D4 | T |
| AA25 | PR40B | 8 | D5 | C | PR54B | 8 | D5 | C |
| AB26 | PR40A | 8 | D6 | T | PR54A | 8 | D6 | T |
| W23 | PR39B | 8 | D7/SPID0 | C | PR53B | 8 | D7/SPID0 | C |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| V22 | PR39A | 8 | DI/CSSPI0N | T | PR53A | 8 | DI/CSSPI0N | T |
| Y24 | PR38B | 8 | DOUT/CSON | C | PR52B | 8 | DOUT/CSON | C |
| Y25 | PR38A | 8 | BUSY/SISPI | T | PR52A | 8 | BUSY/SISPI | T |
| W24 | PR37B | 3 | RDQ34 | C | PR51B | 3 | RDQ48 | C |
| GND | GNDIO3 | - | | | GNDIO3 | - | | |
| V23 | PR37A | 3 | RDQ34 | T | PR51A | 3 | RDQ48 | T |
| AA26 | PR36B | 3 | RDQ34 | C (LVDS)* | PR50B | 3 | RDQ48 | C (LVDS)* |
| Y26 | PR36A | 3 | RDQ34 | T (LVDS)* | PR50A | 3 | RDQ48 | T (LVDS)* |
| U21 | PR35B | 3 | RDQ34 | C | PR49B | 3 | RDQ48 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| U19 | PR35A | 3 | RDQ34 | T | PR49A | 3 | RDQ48 | T |
| W25 | PR34B | 3 | RDQ34 | C (LVDS)* | PR48B | 3 | RDQ48 | C (LVDS)* |
| W26 | PR34A | 3 | RDQS34 | T (LVDS)* | PR48A | 3 | RDQS48 | T (LVDS)* |
| GND | GNDIO3 | - | | | GNDIO3 | - | | |
| V24 | PR33B | 3 | RDQ34 | C | PR47B | 3 | RDQ48 | C |
| V25 | PR33A | 3 | RDQ34 | T | PR47A | 3 | RDQ48 | T |
| V26 | PR32B | 3 | RDQ34 | C (LVDS)* | PR46B | 3 | RDQ48 | C (LVDS)* |
| U26 | PR32A | 3 | RDQ34 | T (LVDS)* | PR46A | 3 | RDQ48 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| U22 | PR31B | 3 | RLM0_GPLL_C_FB_A/RDQ34 | C | PR45B | 3 | RLM0_GPLL_C_FB_A/RDQ48 | C |
| U23 | PR31A | 3 | RLM0_GPLL_T_FB_A/RDQ34 | T | PR45A | 3 | RLM0_GPLL_T_FB_A/RDQ48 | T |
| U24 | PR30B | 3 | RLM0_GPLL_C_IN_A**/RDQ34 | C (LVDS)* | PR44B | 3 | RLM0_GPLL_C_IN_A**/RDQ48 | C (LVDS)* |
| U25 | PR30A | 3 | RLM0_GPLL_T_IN_A**/RDQ34 | T (LVDS)* | PR44A | 3 | RLM0_GPLL_T_IN_A**/RDQ48 | T (LVDS)* |
| R20 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| P18 | VCC | 3 | | | VCCPLL | 3 | | |
| T19 | PR28B | 3 | RLM0_GDLL_C_FB_A/RDQ25 | C | PR42B | 3 | RLM0_GDLL_C_FB_A/RDQ39 | C |
| U20 | PR28A | 3 | RLM0_GDLL_T_FB_A/RDQ25 | T | PR42A | 3 | RLM0_GDLL_T_FB_A/RDQ39 | T |
| GND | GNDIO3 | - | | | GNDIO3 | - | | |
| T25 | PR27B | 3 | RLM0_GDLL_C_IN_A**/RDQ25 | C (LVDS)* | PR41B | 3 | RLM0_GDLL_C_IN_A**/RDQ39 | C (LVDS)* |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | | |
|---------------|-------------------|------|-------------------------|--------------|-------------------|------|-------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| T26 | PR27A | 3 | RLM0_GDLLT_IN_A**/RDQ25 | T (LVDS)* | PR41A | 3 | RLM0_GDLLT_IN_A**/RDQ39 | T (LVDS)* | |
| T20 | PR26B | 3 | RDQ25 | C | PR40B | 3 | RDQ39 | C | |
| T22 | PR26A | 3 | RDQ25 | T | PR40A | 3 | RDQ39 | T | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| R26 | PR25B | 3 | RDQ25 | C (LVDS)* | PR39B | 3 | RDQ39 | C (LVDS)* | |
| R25 | PR25A | 3 | RDQS25*** | T (LVDS)* | PR39A | 3 | RDQS39*** | T (LVDS)* | |
| R22 | NC | - | | | PR38B | 3 | RDQ39 | C | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| T21 | NC | - | | | PR38A | 3 | RDQ39 | T | |
| P26 | NC | - | | | NC | - | | | |
| P25 | NC | - | | | NC | - | | | |
| R24 | NC | - | | | NC | - | | | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| R23 | NC | - | | | NC | - | | | |
| P20 | NC | - | | | NC | - | | | |
| R19 | NC | - | | | NC | - | | | |
| P21 | NC | - | | | PR34B | 3 | RDQ31 | C | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| P19 | NC | - | | | PR34A | 3 | RDQ31 | T | |
| P23 | NC | - | | | PR33B | 3 | RDQ31 | C (LVDS)* | |
| P22 | NC | - | | | PR33A | 3 | RDQ31 | T (LVDS)* | |
| N22 | NC | - | | | PR32B | 3 | RDQ31 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| R21 | NC | - | | | PR32A | 3 | RDQ31 | T | |
| N26 | NC | - | | | PR31B | 3 | RDQ31 | C (LVDS)* | |
| N25 | NC | - | | | PR31A | 3 | RDQS31 | T (LVDS)* | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| N19 | PR24B | 3 | RDQ25 | C | PR30B | 3 | RDQ31 | C | |
| N20 | PR24A | 3 | RDQ25 | T | PR30A | 3 | RDQ31 | T | |
| M26 | PR23B | 3 | RDQ25 | C (LVDS)* | PR29B | 3 | RDQ31 | C (LVDS)* | |
| M25 | PR23A | 3 | RDQ25 | T (LVDS)* | PR29A | 3 | RDQ31 | T (LVDS)* | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| N18 | PR22B | 3 | VREF2_3/RDQ25 | C | PR28B | 3 | VREF2_3/RDQ31 | C | |
| N21 | PR22A | 3 | VREF1_3/RDQ25 | T | PR28A | 3 | VREF1_3/RDQ31 | T | |
| L26 | PR21B | 3 | PCLKC3_0/RDQ25 | C (LVDS)* | PR27B | 3 | PCLKC3_0/RDQ31 | C (LVDS)* | |
| L25 | PR21A | 3 | PCLKT3_0/RDQ25 | T (LVDS)* | PR27A | 3 | PCLKT3_0/RDQ31 | T (LVDS)* | |
| N24 | PR19B | 2 | PCLKC2_0/RDQ16 | C | PR25B | 2 | PCLKC2_0/RDQ22 | C | |
| M23 | PR19A | 2 | PCLKT2_0/RDQ16 | T | PR25A | 2 | PCLKT2_0/RDQ22 | T | |
| GND | GNDIO2 | - | | | GNDIO2 | - | | | |
| L21 | PR18B | 2 | RDQ16 | C (LVDS)* | PR24B | 2 | RDQ22 | C (LVDS)* | |
| K22 | PR18A | 2 | RDQ16 | T (LVDS)* | PR24A | 2 | RDQ22 | T (LVDS)* | |
| M24 | PR17B | 2 | RDQ16 | C | PR23B | 2 | RDQ22 | C | |
| N23 | PR17A | 2 | RDQ16 | T | PR23A | 2 | RDQ22 | T | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| K26 | PR16B | 2 | RDQ16 | C (LVDS)* | PR22B | 2 | RDQ22 | C (LVDS)* | |
| K25 | PR16A | 2 | RDQS16 | T (LVDS)* | PR22A | 2 | RDQS22 | T (LVDS)* | |
| M20 | PR15B | 2 | RDQ16 | C | PR21B | 2 | RDQ22 | C | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| M19 | PR15A | 2 | RDQ16 | T | PR21A | 2 | RDQ22 | T |
| L22 | PR14B | 2 | RDQ16 | C (LVDS)* | PR20B | 2 | RDQ22 | C (LVDS)* |
| M22 | PR14A | 2 | RDQ16 | T (LVDS)* | PR20A | 2 | RDQ22 | T (LVDS)* |
| K21 | PR13B | 2 | RDQ16 | C | PR19B | 2 | RDQ22 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M21 | PR13A | 2 | RDQ16 | T | PR19A | 2 | RDQ22 | T |
| K24 | PR12B | 2 | RDQ16 | C (LVDS)* | PR18B | 2 | RDQ22 | C (LVDS)* |
| J24 | PR12A | 2 | RDQ16 | T (LVDS)* | PR18A | 2 | RDQ22 | T (LVDS)* |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L20 | VCC | - | | | NC | - | | |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| J26 | NC | - | | | NC | - | | |
| J25 | NC | - | | | NC | - | | |
| J23 | NC | - | | | NC | - | | |
| K23 | NC | - | | | NC | - | | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H26 | NC | - | | | NC | - | | |
| H25 | NC | - | | | NC | - | | |
| H24 | NC | - | | | NC | - | | |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| H23 | NC | - | | | NC | - | | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| G26 | PR11B | 2 | RDQ8 | C | PR17B | 2 | RDQ14 | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| G25 | PR11A | 2 | RDQ8 | T | PR17A | 2 | RDQ14 | T |
| F26 | PR10B | 2 | RDQ8 | C (LVDS)* | PR16B | 2 | RDQ14 | C (LVDS)* |
| F25 | PR10A | 2 | RDQ8 | T (LVDS)* | PR16A | 2 | RDQ14 | T (LVDS)* |
| K20 | PR9B | 2 | RDQ8 | C | PR15B | 2 | RDQ14 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L19 | PR9A | 2 | RDQ8 | T | PR15A | 2 | RDQ14 | T |
| E26 | PR8B | 2 | RDQ8 | C (LVDS)* | PR14B | 2 | RDQ14 | C (LVDS)* |
| E25 | PR8A | 2 | RDQS8 | T (LVDS)* | PR14A | 2 | RDQS14 | T (LVDS)* |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| J22 | PR7B | 2 | RDQ8 | C | PR13B | 2 | RDQ14 | C |
| H22 | PR7A | 2 | RDQ8 | T | PR13A | 2 | RDQ14 | T |
| G24 | PR6B | 2 | RDQ8 | C (LVDS)* | PR12B | 2 | RDQ14 | C (LVDS)* |
| G23 | PR6A | 2 | RDQ8 | T (LVDS)* | PR12A | 2 | RDQ14 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K19 | PR5B | 2 | RDQ8 | C | PR11B | 2 | RDQ14 | C |
| J19 | PR5A | 2 | RDQ8 | T | PR11A | 2 | RDQ14 | T |
| D26 | PR4B | 2 | RDQ8 | C (LVDS)* | PR10B | 2 | RDQ14 | C (LVDS)* |
| C26 | PR4A | 2 | RDQ8 | T (LVDS)* | PR10A | 2 | RDQ14 | T (LVDS)* |
| F22 | NC | - | | | PR9B | 2 | RDQ6 | C |
| E24 | NC | - | | | PR9A | 2 | RDQ6 | T |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D25 | NC | - | | | PR8B | 2 | RDQ6 | C (LVDS)* |
| C25 | NC | - | | | PR8A | 2 | RDQ6 | T (LVDS)* |
| D24 | NC | - | | | PR7B | 2 | RDQ6 | C |
| B25 | NC | - | | | PR7A | 2 | RDQ6 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H21 | NC | - | | | PR6B | 2 | RDQ6 | C (LVDS)* |
| G22 | NC | - | | | PR6A | 2 | RDQS6 | T (LVDS)* |
| B24 | NC | - | | | PR5B | 2 | RDQ6 | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| C24 | NC | - | | | PR5A | 2 | RDQ6 | T |
| D23 | NC | - | | | PR4B | 2 | RDQ6 | C (LVDS)* |
| C23 | NC | - | | | PR4A | 2 | RDQ6 | T (LVDS)* |
| G21 | PR3B | 2 | | C | PR3B | 2 | RDQ6 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H20 | PR3A | 2 | | T | PR3A | 2 | RDQ6 | T |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| E22 | PR2B | 2 | VREF2_2 | C (LVDS)* | PR2B | 2 | VREF2_2/RDQ6 | C (LVDS)* |
| F21 | PR2A | 2 | VREF1_2 | T (LVDS)* | PR2A | 2 | VREF1_2/RDQ6 | T (LVDS)* |
| E23 | PT64B | 1 | VREF2_1 | C | PT73B | 1 | VREF2_1 | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| D22 | PT64A | 1 | VREF1_1 | T | PT73A | 1 | VREF1_1 | T |
| G20 | PT63B | 1 | | C | PT72B | 1 | | C |
| J18 | PT63A | 1 | | T | PT72A | 1 | | T |
| F20 | PT62B | 1 | | C | PT71B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H19 | PT62A | 1 | | T | PT71A | 1 | | T |
| A24 | PT61B | 1 | | C | PT70B | 1 | | C |
| A23 | PT61A | 1 | | T | PT70A | 1 | | T |
| E21 | PT60B | 1 | | C | PT69B | 1 | | C |
| F19 | PT60A | 1 | | T | PT69A | 1 | | T |
| C22 | PT59B | 1 | | C | PT68B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| E20 | PT59A | 1 | | T | PT68A | 1 | | T |
| B22 | PT58B | 1 | | C | PT67B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| B23 | PT58A | 1 | | T | PT67A | 1 | | T |
| C20 | PT57B | 1 | | C | PT66B | 1 | | C |
| D20 | PT57A | 1 | | T | PT66A | 1 | | T |
| A22 | PT56B | 1 | | C | PT65B | 1 | | C |
| A21 | PT56A | 1 | | T | PT65A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| E19 | NC | - | | | NC | - | | |
| C19 | NC | - | | | NC | - | | |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| B21 | NC | - | | | NC | - | | |
| B20 | NC | - | | | NC | - | | |
| D19 | NC | - | | | NC | - | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| B19 | NC | - | | | NC | - | | |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| G17 | NC | - | | | NC | - | | |
| E18 | NC | - | | | NC | - | | |
| G19 | NC | - | | | NC | - | | |
| F17 | NC | - | | | NC | - | | |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A20 | NC | - | | | NC | - | | |
| A19 | NC | - | | | NC | - | | |
| E17 | NC | - | | | NC | - | | |
| D18 | NC | - | | | NC | - | | |
| B18 | PT55B | 1 | | C | PT55B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| A18 | PT55A | 1 | | T | PT55A | 1 | | T |
| E16 | PT54B | 1 | | C | PT54B | 1 | | C |
| G16 | PT54A | 1 | | T | PT54A | 1 | | T |
| F16 | PT53B | 1 | | C | PT53B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H18 | PT53A | 1 | | T | PT53A | 1 | | T |
| A17 | PT52B | 1 | | C | PT52B | 1 | | C |
| B17 | PT52A | 1 | | T | PT52A | 1 | | T |
| C18 | PT51B | 1 | | C | PT51B | 1 | | C |
| B16 | PT51A | 1 | | T | PT51A | 1 | | T |
| C17 | PT50B | 1 | | C | PT50B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| D17 | PT50A | 1 | | T | PT50A | 1 | | T |
| E15 | PT49B | 1 | | C | PT49B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G15 | PT49A | 1 | | T | PT49A | 1 | | T |
| A16 | PT48B | 1 | | C | PT48B | 1 | | C |
| B15 | PT48A | 1 | | T | PT48A | 1 | | T |
| D15 | PT47B | 1 | | C | PT47B | 1 | | C |
| F15 | PT47A | 1 | | T | PT47A | 1 | | T |
| A14 | PT46B | 1 | | C | PT46B | 1 | | C |
| B14 | PT46A | 1 | | T | PT46A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| C15 | PT45B | 1 | | C | PT45B | 1 | | C |
| A15 | PT45A | 1 | | T | PT45A | 1 | | T |
| A13 | PT44B | 1 | | C | PT44B | 1 | | C |
| B13 | PT44A | 1 | | T | PT44A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H17 | PT43B | 1 | | C | PT43B | 1 | | C |
| H15 | PT43A | 1 | | T | PT43A | 1 | | T |
| D13 | PT42B | 1 | | C | PT42B | 1 | | C |
| C14 | PT42A | 1 | | T | PT42A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| G14 | PT41B | 1 | | C | PT41B | 1 | | C |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E14 | PT41A | 1 | | T | PT41A | 1 | | T |
| A12 | PT40B | 1 | | C | PT40B | 1 | | C |
| B12 | PT40A | 1 | | T | PT40A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F14 | PT39B | 1 | PCLKC1_0 | C | PT39B | 1 | PCLKC1_0 | C |
| D14 | PT39A | 1 | PCLKT1_0 | T | PT39A | 1 | PCLKT1_0 | T |
| H16 | XRES | 1 | | | XRES | 1 | | |
| H14 | PT37B | 0 | PCLKC0_0 | C | PT37B | 0 | PCLKC0_0 | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| H13 | PT37A | 0 | PCLKT0_0 | T | PT37A | 0 | PCLKT0_0 | T |
| A11 | PT36B | 0 | | C | PT36B | 0 | | C |
| B11 | PT36A | 0 | | T | PT36A | 0 | | T |
| C13 | PT35B | 0 | | C | PT35B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E13 | PT35A | 0 | | T | PT35A | 0 | | T |
| D12 | PT34B | 0 | | C | PT34B | 0 | | C |
| F13 | PT34A | 0 | | T | PT34A | 0 | | T |
| A10 | PT33B | 0 | | C | PT33B | 0 | | C |
| B10 | PT33A | 0 | | T | PT33A | 0 | | T |
| C12 | PT32B | 0 | | C | PT32B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| C10 | PT32A | 0 | | T | PT32A | 0 | | T |
| G13 | PT31B | 0 | | C | PT31B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H12 | PT31A | 0 | | T | PT31A | 0 | | T |
| A9 | PT30B | 0 | | C | PT30B | 0 | | C |
| B9 | PT30A | 0 | | T | PT30A | 0 | | T |
| E12 | PT29B | 0 | | C | PT29B | 0 | | C |
| G12 | PT29A | 0 | | T | PT29A | 0 | | T |
| A8 | PT28B | 0 | | C | PT28B | 0 | | C |
| B8 | PT28A | 0 | | T | PT28A | 0 | | T |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| E11 | PT27B | 0 | | C | PT27B | 0 | | C |
| C9 | PT27A | 0 | | T | PT27A | 0 | | T |
| A7 | PT26B | 0 | | C | PT26B | 0 | | C |
| B7 | PT26A | 0 | | T | PT26A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F12 | PT25B | 0 | | C | PT25B | 0 | | C |
| D10 | PT25A | 0 | | T | PT25A | 0 | | T |
| H11 | PT24B | 0 | | C | PT24B | 0 | | C |
| G11 | PT24A | 0 | | T | PT24A | 0 | | T |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| A6 | PT23B | 0 | | C | PT23B | 0 | | C |
| B6 | PT23A | 0 | | T | PT23A | 0 | | T |
| D8 | PT22B | 0 | | C | PT22B | 0 | | C |
| C8 | PT22A | 0 | | T | PT22A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F11 | PT21B | 0 | | C | PT21B | 0 | | C |
| E10 | PT21A | 0 | | T | PT21A | 0 | | T |
| E9 | PT20B | 0 | | C | PT20B | 0 | | C |
| D9 | PT20A | 0 | | T | PT20A | 0 | | T |
| G10 | PT19B | 0 | | C | PT19B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| H10 | PT19A | 0 | | T | PT19A | 0 | | T |
| A5 | PT18B | 0 | | C | PT18B | 0 | | C |
| B5 | PT18A | 0 | | T | PT18A | 0 | | T |
| C7 | PT17B | 0 | | C | PT17B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D7 | PT17A | 0 | | T | PT17A | 0 | | T |
| E8 | PT16B | 0 | | C | PT16B | 0 | | C |
| F10 | PT16A | 0 | | T | PT16A | 0 | | T |
| F8 | PT15B | 0 | | C | PT15B | 0 | | C |
| H9 | PT15A | 0 | | T | PT15A | 0 | | T |
| C5 | PT14B | 0 | | C | PT14B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| D5 | PT14A | 0 | | T | PT14A | 0 | | T |
| B4 | PT13B | 0 | | | PT13B | 0 | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C4 | PT10B | 0 | | C | PT10B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| C3 | PT10A | 0 | | T | PT10A | 0 | | T |
| A4 | PT9B | 0 | | C | PT9B | 0 | | C |
| A3 | PT9A | 0 | | T | PT9A | 0 | | T |
| B3 | PT8B | 0 | | C | PT8B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| B2 | PT8A | 0 | | T | PT8A | 0 | | T |
| D4 | PT7B | 0 | | C | PT7B | 0 | | C |
| D3 | PT7A | 0 | | T | PT7A | 0 | | T |
| C2 | PT6B | 0 | | C | PT6B | 0 | | C |
| C1 | PT6A | 0 | | T | PT6A | 0 | | T |
| G8 | PT5B | 0 | | C | PT5B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| G7 | PT5A | 0 | | T | PT5A | 0 | | T |
| E7 | PT4B | 0 | | C | PT4B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F7 | PT4A | 0 | | T | PT4A | 0 | | T |
| E6 | PT3B | 0 | | C | PT3B | 0 | | C |
| E5 | PT3A | 0 | | T | PT3A | 0 | | T |
| G6 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| G5 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| L12 | VCC | - | | | VCC | - | | |
| L13 | VCC | - | | | VCC | - | | |
| L14 | VCC | - | | | VCC | - | | |
| L15 | VCC | - | | | VCC | - | | |
| M11 | VCC | - | | | VCC | - | | |
| M12 | VCC | - | | | VCC | - | | |
| M15 | VCC | - | | | VCC | - | | |
| M16 | VCC | - | | | VCC | - | | |
| N11 | VCC | - | | | VCC | - | | |
| N16 | VCC | - | | | VCC | - | | |
| P11 | VCC | - | | | VCC | - | | |
| P16 | VCC | - | | | VCC | - | | |
| R11 | VCC | - | | | VCC | - | | |
| R12 | VCC | - | | | VCC | - | | |
| R15 | VCC | - | | | VCC | - | | |
| R16 | VCC | - | | | VCC | - | | |
| T12 | VCC | - | | | VCC | - | | |
| T13 | VCC | - | | | VCC | - | | |
| T14 | VCC | - | | | VCC | - | | |
| T15 | VCC | - | | | VCC | - | | |
| D11 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D6 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| K12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| J12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D16 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D21 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G18 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| J15 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| K15 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F23 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J20 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L23 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M17 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M18 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| AA23 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R17 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R18 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| T23 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| V20 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AC16 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC21 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| U15 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| V15 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| Y18 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC11 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AC6 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| U12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| V12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| Y9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA4 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R10 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R9 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| T4 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| F4 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L4 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M9 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| AE25 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| V18 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| J10 | VCCAUX | - | | | VCCAUX | - | | |
| J11 | VCCAUX | - | | | VCCAUX | - | | |
| J16 | VCCAUX | - | | | VCCAUX | - | | |
| J17 | VCCAUX | - | | | VCCAUX | - | | |
| K18 | VCCAUX | - | | | VCCAUX | - | | |
| K9 | VCCAUX | - | | | VCCAUX | - | | |
| L18 | VCCAUX | - | | | VCCAUX | - | | |
| L9 | VCCAUX | - | | | VCCAUX | - | | |
| T18 | VCCAUX | - | | | VCCAUX | - | | |
| T9 | VCCAUX | - | | | VCCAUX | - | | |
| U18 | VCCAUX | - | | | VCCAUX | - | | |
| U9 | VCCAUX | - | | | VCCAUX | - | | |
| V10 | VCCAUX | - | | | VCCAUX | - | | |
| V11 | VCCAUX | - | | | VCCAUX | - | | |
| V16 | VCCAUX | - | | | VCCAUX | - | | |
| V17 | VCCAUX | - | | | VCCAUX | - | | |
| A2 | GND | - | | | GND | - | | |
| A25 | GND | - | | | GND | - | | |
| AA18 | GND | - | | | GND | - | | |
| AA24 | GND | - | | | GND | - | | |
| AA3 | GND | - | | | GND | - | | |
| AA9 | GND | - | | | GND | - | | |
| AD11 | GND | - | | | GND | - | | |
| AD16 | GND | - | | | GND | - | | |
| AD21 | GND | - | | | GND | - | | |
| AD6 | GND | - | | | GND | - | | |
| AE1 | GND | - | | | GND | - | | |
| AE26 | GND | - | | | GND | - | | |
| AF2 | GND | - | | | GND | - | | |
| AF25 | GND | - | | | GND | - | | |
| B1 | GND | - | | | GND | - | | |
| B26 | GND | - | | | GND | - | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| C11 | GND | - | | | GND | - | | |
| C16 | GND | - | | | GND | - | | |
| C21 | GND | - | | | GND | - | | |
| C6 | GND | - | | | GND | - | | |
| F18 | GND | - | | | GND | - | | |
| F24 | GND | - | | | GND | - | | |
| F3 | GND | - | | | GND | - | | |
| F9 | GND | - | | | GND | - | | |
| J13 | GND | - | | | GND | - | | |
| J14 | GND | - | | | GND | - | | |
| J21 | GND | - | | | GND | - | | |
| J6 | GND | - | | | GND | - | | |
| K10 | GND | - | | | GND | - | | |
| K11 | GND | - | | | GND | - | | |
| K13 | GND | - | | | GND | - | | |
| K14 | GND | - | | | GND | - | | |
| K16 | GND | - | | | GND | - | | |
| K17 | GND | - | | | GND | - | | |
| L10 | GND | - | | | GND | - | | |
| L11 | GND | - | | | GND | - | | |
| L16 | GND | - | | | GND | - | | |
| L17 | GND | - | | | GND | - | | |
| L24 | GND | - | | | GND | - | | |
| L3 | GND | - | | | GND | - | | |
| M13 | GND | - | | | GND | - | | |
| M14 | GND | - | | | GND | - | | |
| N10 | GND | - | | | GND | - | | |
| N12 | GND | - | | | GND | - | | |
| N13 | GND | - | | | GND | - | | |
| N14 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N17 | GND | - | | | GND | - | | |
| P10 | GND | - | | | GND | - | | |
| P12 | GND | - | | | GND | - | | |
| P13 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P15 | GND | - | | | GND | - | | |
| P17 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| R14 | GND | - | | | GND | - | | |
| T10 | GND | - | | | GND | - | | |
| T11 | GND | - | | | GND | - | | |
| T16 | GND | - | | | GND | - | | |
| T17 | GND | - | | | GND | - | | |
| T24 | GND | - | | | GND | - | | |
| T3 | GND | - | | | GND | - | | |
| U10 | GND | - | | | GND | - | | |

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA

| LFE2-20E/20SE | | | | | LFE2-35E/35SE | | | |
|---------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| U11 | GND | - | | | GND | - | | |
| U13 | GND | - | | | GND | - | | |
| U14 | GND | - | | | GND | - | | |
| U16 | GND | - | | | GND | - | | |
| U17 | GND | - | | | GND | - | | |
| V13 | GND | - | | | GND | - | | |
| V14 | GND | - | | | GND | - | | |
| V21 | GND | - | | | GND | - | | |
| V6 | GND | - | | | GND | - | | |
| M3 | NC | - | | | NC | - | | |
| N6 | NC | - | | | NC | - | | |
| P24 | NC | - | | | NC | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D2 | PL2A | 7 | VREF2_7 | T (LVDS)* | PL2A | 7 | VREF2_7 | T (LVDS)* |
| D1 | PL2B | 7 | VREF1_7 | C (LVDS)* | PL2B | 7 | VREF1_7 | C (LVDS)* |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| F6 | PL5A | 7 | LDQ8 | T | PL18A | 7 | LDQ21 | T |
| F5 | PL5B | 7 | LDQ8 | C | PL18B | 7 | LDQ21 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| E4 | PL6A | 7 | LDQ8 | T (LVDS)* | PL19A | 7 | LDQ21 | T (LVDS)* |
| E3 | PL6B | 7 | LDQ8 | C (LVDS)* | PL19B | 7 | LDQ21 | C (LVDS)* |
| E2 | PL7A | 7 | LDQ8 | T | PL20A | 7 | LDQ21 | T |
| E1 | PL7B | 7 | LDQ8 | C | PL20B | 7 | LDQ21 | C |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| H6 | PL8A | 7 | LDQS8 | T (LVDS)* | PL21A | 7 | LDQS21 | T (LVDS)* |
| H5 | PL8B | 7 | LDQ8 | C (LVDS)* | PL21B | 7 | LDQ21 | C (LVDS)* |
| F2 | PL9A | 7 | LDQ8 | T | PL22A | 7 | LDQ21 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| F1 | PL9B | 7 | LDQ8 | C | PL22B | 7 | LDQ21 | C |
| H8 | PL10A | 7 | LDQ8 | T (LVDS)* | PL23A | 7 | LDQ21 | T (LVDS)* |
| J9 | PL10B | 7 | LDQ8 | C (LVDS)* | PL23B | 7 | LDQ21 | C (LVDS)* |
| G4 | PL11A | 7 | LDQ8 | T | PL24A | 7 | LDQ21 | T |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| G3 | PL11B | 7 | LDQ8 | C | PL24B | 7 | LDQ21 | C |
| H7 | PL12A | 7 | LDQ16 | T (LVDS)* | PL25A | 7 | LDQ29 | T (LVDS)* |
| J8 | PL12B | 7 | LDQ16 | C (LVDS)* | PL25B | 7 | LDQ29 | C (LVDS)* |
| G2 | PL13A | 7 | LDQ16 | T | PL26A | 7 | LDQ29 | T |
| G1 | PL13B | 7 | LDQ16 | C | PL26B | 7 | LDQ29 | C |
| H3 | PL14A | 7 | LDQ16 | T (LVDS)* | PL27A | 7 | LDQ29 | T (LVDS)* |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| H4 | PL14B | 7 | LDQ16 | C (LVDS)* | PL27B | 7 | LDQ29 | C (LVDS)* |
| J5 | PL15A | 7 | LDQ16 | T | PL28A | 7 | LDQ29 | T |
| J4 | PL15B | 7 | LDQ16 | C | PL28B | 7 | LDQ29 | C |
| J3 | PL16A | 7 | LDQS16 | T (LVDS)* | PL29A | 7 | LDQS29 | T (LVDS)* |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| K4 | PL16B | 7 | LDQ16 | C (LVDS)* | PL29B | 7 | LDQ29 | C (LVDS)* |
| H1 | PL17A | 7 | LDQ16 | T | PL30A | 7 | LDQ29 | T |
| H2 | PL17B | 7 | LDQ16 | C | PL30B | 7 | LDQ29 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K6 | PL18A | 7 | LDQ16 | T (LVDS)* | PL31A | 7 | LDQ29 | T (LVDS)* |
| K7 | PL18B | 7 | LDQ16 | C (LVDS)* | PL31B | 7 | LDQ29 | C (LVDS)* |
| J1 | PL19A | 7 | LDQ16 | T | PL32A | 7 | LDQ29 | T |
| J2 | PL19B | 7 | LDQ16 | C | PL32B | 7 | LDQ29 | C |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K3 | PL23A | 7 | LDQ24 | T | PL36A | 7 | LDQ37 | T |
| K2 | PL23B | 7 | LDQ24 | C | PL36B | 7 | LDQ37 | C |
| GND | GNDIO7 | - | | | GNDIO7 | - | | |
| K1 | PL24A | 7 | LDQS24*** | T (LVDS)* | PL37A | 7 | LDQS37*** | T (LVDS)* |
| L2 | PL24B | 7 | LDQ24 | C (LVDS)* | PL37B | 7 | LDQ37 | C (LVDS)* |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| L1 | PL25A | 7 | LUM0_SPLLT_IN_A/LDQ24 | T | PL38A | 7 | LUM0_SPLLT_IN_A/LDQ37 | T | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| M2 | PL25B | 7 | LUM0_SPLLC_IN_A/LDQ24 | C | PL38B | 7 | LUM0_SPLLC_IN_A/LDQ37 | C | |
| M1 | PL26A | 7 | LUM0_SPLLT_FB_A/LDQ24 | T | PL39A | 7 | LUM0_SPLLT_FB_A/LDQ37 | T | |
| N2 | PL26B | 7 | LUM0_SPLLC_FB_A/LDQ24 | C | PL39B | 7 | LUM0_SPLLC_FB_A/LDQ37 | C | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| M8 | VCCPLL | 7 | | | NC | - | | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| N1 | PL37A | 7 | LDQ41 | | PL50A | 7 | LDQ54 | | |
| L8 | PL38A | 7 | LDQ41 | T | PL51A | 7 | LDQ54 | T | |
| K8 | PL38B | 7 | LDQ41 | C | PL51B | 7 | LDQ54 | C | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| L6 | PL39A | 7 | LDQ41 | T (LVDS)* | PL52A | 7 | LDQ54 | T (LVDS)* | |
| K5 | PL39B | 7 | LDQ41 | C (LVDS)* | PL52B | 7 | LDQ54 | C (LVDS)* | |
| L7 | PL40A | 7 | LDQ41 | T | PL53A | 7 | LDQ54 | T | |
| L5 | PL40B | 7 | LDQ41 | C | PL53B | 7 | LDQ54 | C | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| P1 | PL41A | 7 | LDQS41 | T (LVDS)* | PL54A | 7 | LDQS54 | T (LVDS)* | |
| P2 | PL41B | 7 | LDQ41 | C (LVDS)* | PL54B | 7 | LDQ54 | C (LVDS)* | |
| M6 | PL42A | 7 | LDQ41 | T | PL55A | 7 | LDQ54 | T | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| N8 | PL42B | 7 | LDQ41 | C | PL55B | 7 | LDQ54 | C | |
| R1 | PL43A | 7 | LDQ41 | T (LVDS)* | PL56A | 7 | LDQ54 | T (LVDS)* | |
| R2 | PL43B | 7 | LDQ41 | C (LVDS)* | PL56B | 7 | LDQ54 | C (LVDS)* | |
| M7 | PL44A | 7 | PCLKT7_0/LDQ41 | T | PL57A | 7 | PCLKT7_0/LDQ54 | T | |
| GND | GNDIO7 | - | | | GNDIO7 | - | | | |
| N9 | PL44B | 7 | PCLKC7_0/LDQ41 | C | PL57B | 7 | PCLKC7_0/LDQ54 | C | |
| M4 | PL46A | 6 | PCLKT6_0/LDQ50 | T (LVDS)* | PL59A | 6 | PCLKT6_0/LDQ63 | T (LVDS)* | |
| M5 | PL46B | 6 | PCLKC6_0/LDQ50 | C (LVDS)* | PL59B | 6 | PCLKC6_0/LDQ63 | C (LVDS)* | |
| N7 | PL47A | 6 | VREF2_6/LDQ50 | T | PL60A | 6 | VREF2_6/LDQ63 | T | |
| P9 | PL47B | 6 | VREF1_6/LDQ50 | C | PL60B | 6 | VREF1_6/LDQ63 | C | |
| N3 | PL48A | 6 | LDQ50 | T (LVDS)* | PL61A | 6 | LDQ63 | T (LVDS)* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| N4 | PL48B | 6 | LDQ50 | C (LVDS)* | PL61B | 6 | LDQ63 | C (LVDS)* | |
| N5 | PL49A | 6 | LDQ50 | T | PL62A | 6 | LDQ63 | T | |
| P7 | PL49B | 6 | LDQ50 | C | PL62B | 6 | LDQ63 | C | |
| T1 | PL50A | 6 | LDQS50 | T (LVDS)* | PL63A | 6 | LDQS63 | T (LVDS)* | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| T2 | PL50B | 6 | LDQ50 | C (LVDS)* | PL63B | 6 | LDQ63 | C (LVDS)* | |
| P8 | PL51A | 6 | LDQ50 | T | PL64A | 6 | LDQ63 | T | |
| P6 | PL51B | 6 | LDQ50 | C | PL64B | 6 | LDQ63 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| P5 | PL52A | 6 | LDQ50 | T (LVDS)* | PL65A | 6 | LDQ63 | T (LVDS)* | |
| P4 | PL52B | 6 | LDQ50 | C (LVDS)* | PL65B | 6 | LDQ63 | C (LVDS)* | |
| U1 | PL53A | 6 | LDQ50 | T | PL66A | 6 | LDQ63 | T | |
| V1 | PL53B | 6 | LDQ50 | C | PL66B | 6 | LDQ63 | C | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|-------------------------|--------------|-------------------|------|-------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| P3 | PL54A | 6 | LDQ58 | T (LVDS)* | PL67A | 6 | LDQ71 | T (LVDS)* | |
| R3 | PL54B | 6 | LDQ58 | C (LVDS)* | PL67B | 6 | LDQ71 | C (LVDS)* | |
| R4 | PL55A | 6 | LDQ58 | T | PL68A | 6 | LDQ71 | T | |
| U2 | PL55B | 6 | LDQ58 | C | PL68B | 6 | LDQ71 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| V2 | PL56A | 6 | LDQ58 | T (LVDS)* | PL69A | 6 | LDQ71 | T (LVDS)* | |
| W2 | PL56B | 6 | LDQ58 | C (LVDS)* | PL69B | 6 | LDQ71 | C (LVDS)* | |
| T6 | PL57A | 6 | LDQ58 | T | PL70A | 6 | LDQ71 | T | |
| R5 | PL57B | 6 | LDQ58 | C | PL70B | 6 | LDQ71 | C | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| R6 | PL58A | 6 | LDQS58 | T (LVDS)* | PL71A | 6 | LDQS71 | T (LVDS)* | |
| R7 | PL58B | 6 | LDQ58 | C (LVDS)* | PL71B | 6 | LDQ71 | C (LVDS)* | |
| W1 | PL59A | 6 | LDQ58 | T | PL72A | 6 | LDQ71 | T | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| Y2 | PL59B | 6 | LDQ58 | C | PL72B | 6 | LDQ71 | C | |
| Y1 | PL60A | 6 | LLM0_GDLLT_IN_A**/LDQ58 | T (LVDS)* | PL73A | 6 | LLM0_GDLLT_IN_A**/LDQ71 | T (LVDS)* | |
| AA2 | PL60B | 6 | LLM0_GDLLC_IN_A**/LDQ58 | C (LVDS)* | PL73B | 6 | LLM0_GDLLC_IN_A**/LDQ71 | C (LVDS)* | |
| T5 | PL61A | 6 | LLM0_GDLLT_FB_A/LDQ58 | T | PL74A | 6 | LLM0_GDLLT_FB_A/LDQ71 | T | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| T7 | PL61B | 6 | LLM0_GDLLC_FB_D/LDQ58 | C | PL74B | 6 | LLM0_GDLLC_FB_D/LDQ71 | C | |
| R8 | VCCPLL | 6 | | | VCCPLL | - | | | |
| T8 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | | |
| U3 | PL63A | 6 | LLM0_GPLLT_IN_A**/LDQ67 | T (LVDS)* | PL76A | 6 | LLM0_GPLLT_IN_A**/LDQ80 | T (LVDS)* | |
| U4 | PL63B | 6 | LLM0_GPLLC_IN_A**/LDQ67 | C (LVDS)* | PL76B | 6 | LLM0_GPLLC_IN_A**/LDQ80 | C (LVDS)* | |
| V3 | PL64A | 6 | LLM0_GPLLT_FB_A/LDQ67 | T | PL77A | 6 | LLM0_GPLLT_FB_A/LDQ80 | T | |
| U5 | PL64B | 6 | LLM0_GPLLC_FB_A/LDQ67 | C | PL77B | 6 | LLM0_GPLLC_FB_A/LDQ80 | C | |
| V4 | PL65A | 6 | LDQ67 | T (LVDS)* | PL78A | 6 | LDQ80 | T (LVDS)* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| V5 | PL65B | 6 | LDQ67 | C (LVDS)* | PL78B | 6 | LDQ80 | C (LVDS)* | |
| Y3 | PL66A | 6 | LDQ67 | T | PL79A | 6 | LDQ80 | T | |
| Y4 | PL66B | 6 | LDQ67 | C | PL79B | 6 | LDQ80 | C | |
| W3 | PL67A | 6 | LDQS67 | T (LVDS)* | PL80A | 6 | LDQS80 | T (LVDS)* | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| W4 | PL67B | 6 | LDQ67 | C (LVDS)* | PL80B | 6 | LDQ80 | C (LVDS)* | |
| AA1 | PL68A | 6 | LDQ67 | T | PL81A | 6 | LDQ80 | T | |
| AB1 | PL68B | 6 | LDQ67 | C | PL81B | 6 | LDQ80 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| U8 | PL69A | 6 | LDQ67 | T (LVDS)* | PL82A | 6 | LDQ80 | T (LVDS)* | |
| U7 | PL69B | 6 | LDQ67 | C (LVDS)* | PL82B | 6 | LDQ80 | C (LVDS)* | |
| V8 | PL70A | 6 | LDQ67 | T | PL83A | 6 | LDQ80 | T | |
| U6 | PL70B | 6 | LDQ67 | C | PL83B | 6 | LDQ80 | C | |
| GND | GNDIO6 | - | | | GNDIO6 | - | | | |
| W6 | PL71A | 6 | LDQ75 | T (LVDS)* | PL84A | 6 | LDQ88 | T (LVDS)* | |
| W5 | PL71B | 6 | LDQ75 | C (LVDS)* | PL84B | 6 | LDQ88 | C (LVDS)* | |
| AC1 | PL72A | 6 | LDQ75 | T | PL85A | 6 | LDQ88 | T | |
| AD1 | PL72B | 6 | LDQ75 | C | PL85B | 6 | LDQ88 | C | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y6 | PL73A | 6 | LDQ75 | T (LVDS)* | PL86A | 6 | LDQ88 | T (LVDS)* |
| Y5 | PL73B | 6 | LDQ75 | C (LVDS)* | PL86B | 6 | LDQ88 | C (LVDS)* |
| AE2 | PL74A | 6 | LDQ75 | T | PL87A | 6 | LDQ88 | T |
| AD2 | PL74B | 6 | LDQ75 | C | PL87B | 6 | LDQ88 | C |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| AB3 | PL75A | 6 | LDQS75 | T (LVDS)* | PL88A | 6 | LDQS88 | T (LVDS)* |
| AB2 | PL75B | 6 | LDQ75 | C (LVDS)* | PL88B | 6 | LDQ88 | C (LVDS)* |
| W7 | PL76A | 6 | LDQ75 | T | PL89A | 6 | LDQ88 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W8 | PL76B | 6 | LDQ75 | C | PL89B | 6 | LDQ88 | C |
| Y7 | PL77A | 6 | LDQ75 | T (LVDS)* | PL90A | 6 | LDQ88 | T (LVDS)* |
| Y8 | PL77B | 6 | LDQ75 | C (LVDS)* | PL90B | 6 | LDQ88 | C (LVDS)* |
| AC2 | PL78A | 6 | LDQ75 | T | PL91A | 6 | LDQ88 | T |
| GND | GNDIO6 | - | | | GNDIO6 | - | | |
| AD3 | PL78B | 6 | LDQ75 | C | PL91B | 6 | LDQ88 | C |
| AC3 | TCK | - | | | TCK | - | | |
| AA8 | TDI | - | | | TDI | - | | |
| AB4 | TMS | - | | | TMS | - | | |
| AA5 | TDO | - | | | TDO | - | | |
| AB5 | VCCJ | - | | | VCCJ | - | | |
| AE3 | PB2A | 5 | VREF2_5/BDQ6 | T | PB2A | 5 | VREF2_5/BDQ6 | T |
| AF3 | PB2B | 5 | VREF1_5/BDQ6 | C | PB2B | 5 | VREF1_5/BDQ6 | C |
| AC4 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T |
| AD4 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C |
| AE4 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T |
| AF4 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| V9 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T |
| W9 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C |
| GND | GNDIO5 | - | | | GNDIO5 | - | | |
| AA6 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T |
| AB6 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C |
| AC5 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T |
| AD5 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C |
| AA7 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T |
| AB7 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AE5 | PB9A | 5 | BDQ6 | T | PB9A | 5 | BDQ6 | T |
| AF5 | PB9B | 5 | BDQ6 | C | PB9B | 5 | BDQ6 | C |
| AC7 | PB10A | 5 | BDQ6 | T | PB10A | 5 | BDQ6 | T |
| AD7 | PB10B | 5 | BDQ6 | C | PB10B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | |
| W10 | PB20A | 5 | BDQ24 | T | PB29A | 5 | BDQ33 | T |
| Y10 | PB20B | 5 | BDQ24 | C | PB29B | 5 | BDQ33 | C |
| W11 | PB21A | 5 | BDQ24 | T | PB30A | 5 | BDQ33 | T |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AA10 | PB21B | 5 | BDQ24 | C | PB30B | 5 | BDQ33 | C | |
| AC8 | PB22A | 5 | BDQ24 | T | PB31A | 5 | BDQ33 | T | |
| AD8 | PB22B | 5 | BDQ24 | C | PB31B | 5 | BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AB8 | PB23A | 5 | BDQ24 | T | PB32A | 5 | BDQ33 | T | |
| AB10 | PB23B | 5 | BDQ24 | C | PB32B | 5 | BDQ33 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AE6 | PB24A | 5 | BDQS24 | T | PB33A | 5 | BDQS33 | T | |
| AF6 | PB24B | 5 | BDQ24 | C | PB33B | 5 | BDQ33 | C | |
| AA11 | PB25A | 5 | BDQ24 | T | PB34A | 5 | BDQ33 | T | |
| AC9 | PB25B | 5 | BDQ24 | C | PB34B | 5 | BDQ33 | C | |
| AB9 | PB26A | 5 | BDQ24 | T | PB35A | 5 | BDQ33 | T | |
| AD9 | PB26B | 5 | BDQ24 | C | PB35B | 5 | BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y11 | PB27A | 5 | BDQ24 | T | PB36A | 5 | BDQ33 | T | |
| AB11 | PB27B | 5 | BDQ24 | C | PB36B | 5 | BDQ33 | C | |
| AE7 | PB28A | 5 | BDQ24 | T | PB37A | 5 | BDQ33 | T | |
| AF7 | PB28B | 5 | BDQ24 | C | PB37B | 5 | BDQ33 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AC10 | PB29A | 5 | BDQ33 | T | PB38A | 5 | BDQ42 | T | |
| AD10 | PB29B | 5 | BDQ33 | C | PB38B | 5 | BDQ42 | C | |
| AA12 | PB30A | 5 | BDQ33 | T | PB39A | 5 | BDQ42 | T | |
| W12 | PB30B | 5 | BDQ33 | C | PB39B | 5 | BDQ42 | C | |
| AB12 | PB31A | 5 | BDQ33 | T | PB40A | 5 | BDQ42 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y12 | PB31B | 5 | BDQ33 | C | PB40B | 5 | BDQ42 | C | |
| AD12 | PB32A | 5 | BDQ33 | T | PB41A | 5 | BDQ42 | T | |
| AC12 | PB32B | 5 | BDQ33 | C | PB41B | 5 | BDQ42 | C | |
| AC13 | PB33A | 5 | BDQS33 | T | PB42A | 5 | BDQS42 | T | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AA13 | PB33B | 5 | BDQ33 | C | PB42B | 5 | BDQ42 | C | |
| AD13 | PB34A | 5 | BDQ33 | T | PB43A | 5 | BDQ42 | T | |
| AC14 | PB34B | 5 | BDQ33 | C | PB43B | 5 | BDQ42 | C | |
| AE8 | PB35A | 5 | BDQ33 | T | PB44A | 5 | BDQ42 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AF8 | PB35B | 5 | BDQ33 | C | PB44B | 5 | BDQ42 | C | |
| AB15 | PB36A | 5 | BDQ33 | T | PB45A | 5 | BDQ42 | T | |
| Y13 | PB36B | 5 | BDQ33 | C | PB45B | 5 | BDQ42 | C | |
| AE9 | PB37A | 5 | BDQ33 | T | PB46A | 5 | BDQ42 | T | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AF9 | PB37B | 5 | BDQ33 | C | PB46B | 5 | BDQ42 | C | |
| W13 | PB38A | 5 | BDQ42 | T | PB47A | 5 | BDQ51 | T | |
| AA14 | PB38B | 5 | BDQ42 | C | PB47B | 5 | BDQ51 | C | |
| AE10 | PB39A | 5 | BDQ42 | T | PB48A | 5 | BDQ51 | T | |
| AF10 | PB39B | 5 | BDQ42 | C | PB48B | 5 | BDQ51 | C | |
| W14 | PB40A | 5 | BDQ42 | T | PB49A | 5 | BDQ51 | T | |
| AB13 | PB40B | 5 | BDQ42 | C | PB49B | 5 | BDQ51 | C | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y14 | PB41A | 5 | BDQ42 | T | PB50A | 5 | BDQ51 | T | |
| AB14 | PB41B | 5 | BDQ42 | C | PB50B | 5 | BDQ51 | C | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AE11 | PB42A | 5 | BDQS42 | T | PB51A | 5 | BDQS51 | T | |
| AF11 | PB42B | 5 | BDQ42 | C | PB51B | 5 | BDQ51 | C | |
| AD14 | PB43A | 5 | BDQ42 | T | PB52A | 5 | BDQ51 | T | |
| AA15 | PB43B | 5 | BDQ42 | C | PB52B | 5 | BDQ51 | C | |
| AE12 | PB44A | 5 | PCLKT5_0/BDQ42 | T | PB53A | 5 | PCLKT5_0/BDQ51 | T | |
| AF12 | PB44B | 5 | PCLKC5_0/BDQ42 | C | PB53B | 5 | PCLKC5_0/BDQ51 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GND | GNDIO5 | - | | | GNDIO5 | - | | | |
| AD15 | PB49A | 4 | PCLKT4_0/BDQ51 | T | PB58A | 4 | PCLKT4_0/BDQ60 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AC15 | PB49B | 4 | PCLKC4_0/BDQ51 | C | PB58B | 4 | PCLKC4_0/BDQ60 | C | |
| AE13 | PB50A | 4 | BDQ51 | T | PB59A | 4 | BDQ60 | T | |
| AF13 | PB50B | 4 | BDQ51 | C | PB59B | 4 | BDQ60 | C | |
| AB17 | PB51A | 4 | BDQS51 | T | PB60A | 4 | BDQS60 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| Y15 | PB51B | 4 | BDQ51 | C | PB60B | 4 | BDQ60 | C | |
| AE14 | PB52A | 4 | BDQ51 | T | PB61A | 4 | BDQ60 | T | |
| AF14 | PB52B | 4 | BDQ51 | C | PB61B | 4 | BDQ60 | C | |
| AA16 | PB53A | 4 | BDQ51 | T | PB62A | 4 | BDQ60 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| W15 | PB53B | 4 | BDQ51 | C | PB62B | 4 | BDQ60 | C | |
| AC17 | PB54A | 4 | BDQ51 | T | PB63A | 4 | BDQ60 | T | |
| AB16 | PB54B | 4 | BDQ51 | C | PB63B | 4 | BDQ60 | C | |
| AE15 | PB55A | 4 | BDQ51 | T | PB64A | 4 | BDQ60 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AF15 | PB55B | 4 | BDQ51 | C | PB64B | 4 | BDQ60 | C | |
| AE16 | PB56A | 4 | BDQ60 | T | PB65A | 4 | BDQ69 | T | |
| AF16 | PB56B | 4 | BDQ60 | C | PB65B | 4 | BDQ69 | C | |
| Y16 | PB57A | 4 | BDQ60 | T | PB66A | 4 | BDQ69 | T | |
| AB18 | PB57B | 4 | BDQ60 | C | PB66B | 4 | BDQ69 | C | |
| AD17 | PB58A | 4 | BDQ60 | T | PB67A | 4 | BDQ69 | T | |
| AD18 | PB58B | 4 | BDQ60 | C | PB67B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AC18 | PB59A | 4 | BDQ60 | T | PB68A | 4 | BDQ69 | T | |
| AD19 | PB59B | 4 | BDQ60 | C | PB68B | 4 | BDQ69 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AC19 | PB60A | 4 | BDQS60 | T | PB69A | 4 | BDQS69 | T | |
| AE17 | PB60B | 4 | BDQ60 | C | PB69B | 4 | BDQ69 | C | |
| AB19 | PB61A | 4 | BDQ60 | T | PB70A | 4 | BDQ69 | T | |
| AE19 | PB61B | 4 | BDQ60 | C | PB70B | 4 | BDQ69 | C | |
| AF17 | PB62A | 4 | BDQ60 | T | PB71A | 4 | BDQ69 | T | |
| AE18 | PB62B | 4 | BDQ60 | C | PB71B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| W16 | PB63A | 4 | BDQ60 | T | PB72A | 4 | BDQ69 | T | |
| AA17 | PB63B | 4 | BDQ60 | C | PB72B | 4 | BDQ69 | C | |
| AF18 | PB64A | 4 | BDQ60 | T | PB73A | 4 | BDQ69 | T | |
| AF19 | PB64B | 4 | BDQ60 | C | PB73B | 4 | BDQ69 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA19 | PB65A | 4 | BDQ69 | T | PB74A | 4 | BDQ78 | T | |
| W17 | PB65B | 4 | BDQ69 | C | PB74B | 4 | BDQ78 | C | |
| Y19 | PB66A | 4 | BDQ69 | T | PB75A | 4 | BDQ78 | T | |
| Y17 | PB66B | 4 | BDQ69 | C | PB75B | 4 | BDQ78 | C | |
| AF20 | PB67A | 4 | BDQ69 | T | PB76A | 4 | BDQ78 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AE20 | PB67B | 4 | BDQ69 | C | PB76B | 4 | BDQ78 | C | |
| AA20 | PB68A | 4 | BDQ69 | T | PB77A | 4 | BDQ78 | T | |
| W18 | PB68B | 4 | BDQ69 | C | PB77B | 4 | BDQ78 | C | |
| AD20 | PB69A | 4 | BDQS69 | T | PB78A | 4 | BDQS78 | T | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AE21 | PB69B | 4 | BDQ69 | C | PB78B | 4 | BDQ78 | C | |
| AF21 | PB70A | 4 | BDQ69 | T | PB79A | 4 | BDQ78 | T | |
| AF22 | PB70B | 4 | BDQ69 | C | PB79B | 4 | BDQ78 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AE22 | PB74A | 4 | BDQ78 | T | PB92A | 4 | BDQ96 | T | |
| AD22 | PB74B | 4 | BDQ78 | C | PB92B | 4 | BDQ96 | C | |
| AF23 | PB75A | 4 | BDQ78 | T | PB93A | 4 | BDQ96 | T | |
| AE23 | PB75B | 4 | BDQ78 | C | PB93B | 4 | BDQ96 | C | |
| AD23 | PB76A | 4 | BDQ78 | T | PB94A | 4 | BDQ96 | T | |
| AC23 | PB76B | 4 | BDQ78 | C | PB94B | 4 | BDQ96 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AB20 | PB77A | 4 | BDQ78 | T | PB95A | 4 | BDQ96 | T | |
| AC20 | PB77B | 4 | BDQ78 | C | PB95B | 4 | BDQ96 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AB21 | PB78A | 4 | BDQS78 | T | PB96A | 4 | BDQS96 | T | |
| AC22 | PB78B | 4 | BDQ78 | C | PB96B | 4 | BDQ96 | C | |
| W19 | PB79A | 4 | BDQ78 | T | PB97A | 4 | BDQ96 | T | |
| AA21 | PB79B | 4 | BDQ78 | C | PB97B | 4 | BDQ96 | C | |
| AF24 | PB80A | 4 | BDQ78 | T | PB98A | 4 | BDQ96 | T | |
| AE24 | PB80B | 4 | BDQ78 | C | PB98B | 4 | BDQ96 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| Y20 | PB81A | 4 | BDQ78 | T | PB99A | 4 | BDQ96 | T | |
| AB22 | PB81B | 4 | BDQ78 | C | PB99B | 4 | BDQ96 | C | |
| Y21 | PB82A | 4 | VREF2_4/BDQ78 | T | PB100A | 4 | VREF2_4/BDQ96 | T | |
| AB23 | PB82B | 4 | VREF1_4/BDQ78 | C | PB100B | 4 | VREF1_4/BDQ96 | C | |
| GND | GNDIO4 | - | | | GNDIO4 | - | | | |
| AD24 | CFG2 | 8 | | | CFG2 | 8 | | | |
| W20 | CFG1 | 8 | | | CFG1 | 8 | | | |
| AC24 | CFG0 | 8 | | | CFG0 | 8 | | | |
| V19 | PROGRAMN | 8 | | | PROGRAMN | 8 | | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|--------------------------|--------------|-------------------|------|--------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AA22 | CCLK | 8 | | | CCLK | 8 | | | |
| AB24 | INITN | 8 | | | INITN | 8 | | | |
| AD25 | DONE | 8 | | | DONE | 8 | | | |
| GND | GNDIO8 | - | | | GNDIO8 | - | | | |
| W21 | PR77B | 8 | WRITEN | C | PR90B | 8 | WRITEN | C | |
| Y22 | PR77A | 8 | CS1N | T | PR90A | 8 | CS1N | T | |
| AC25 | PR76B | 8 | CSN | C | PR89B | 8 | CSN | C | |
| AB25 | PR76A | 8 | D0/SPIFASTN | T | PR89A | 8 | D0/SPIFASTN | T | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| AD26 | PR75B | 8 | D1 | C | PR88B | 8 | D1 | C | |
| AC26 | PR75A | 8 | D2 | T | PR88A | 8 | D2 | T | |
| Y23 | PR74B | 8 | D3 | C | PR87B | 8 | D3 | C | |
| GND | GNDIO8 | - | | | GNDIO8 | - | | | |
| W22 | PR74A | 8 | D4 | T | PR87A | 8 | D4 | T | |
| AA25 | PR73B | 8 | D5 | C | PR86B | 8 | D5 | C | |
| AB26 | PR73A | 8 | D6 | T | PR86A | 8 | D6 | T | |
| W23 | PR72B | 8 | D7/SPID0 | C | PR85B | 8 | D7/SPID0 | C | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| V22 | PR72A | 8 | DI/CSSPI0N | T | PR85A | 8 | DI/CSSPI0N | T | |
| Y24 | PR71B | 8 | DOUT/CSON | C | PR84B | 8 | DOUT/CSON | C | |
| Y25 | PR71A | 8 | BUSY/SISPI | T | PR84A | 8 | BUSY/SISPI | T | |
| W24 | PR70B | 3 | RDQ67 | C | PR83B | 3 | RDQ80 | C | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| V23 | PR70A | 3 | RDQ67 | T | PR83A | 3 | RDQ80 | T | |
| AA26 | PR69B | 3 | RDQ67 | C (LVDS)* | PR82B | 3 | RDQ80 | C (LVDS)* | |
| Y26 | PR69A | 3 | RDQ67 | T (LVDS)* | PR82A | 3 | RDQ80 | T (LVDS)* | |
| U21 | PR68B | 3 | RDQ67 | C | PR81B | 3 | RDQ80 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| U19 | PR68A | 3 | RDQ67 | T | PR81A | 3 | RDQ80 | T | |
| W25 | PR67B | 3 | RDQ67 | C (LVDS)* | PR80B | 3 | RDQ80 | C (LVDS)* | |
| W26 | PR67A | 3 | RDQS67 | T (LVDS)* | PR80A | 3 | RDQS80 | T (LVDS)* | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| V24 | PR66B | 3 | RDQ67 | C | PR79B | 3 | RDQ80 | C | |
| V25 | PR66A | 3 | RDQ67 | T | PR79A | 3 | RDQ80 | T | |
| V26 | PR65B | 3 | RDQ67 | C (LVDS)* | PR78B | 3 | RDQ80 | C (LVDS)* | |
| U26 | PR65A | 3 | RDQ67 | T (LVDS)* | PR78A | 3 | RDQ80 | T (LVDS)* | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| U22 | PR64B | 3 | RLM0_GPLL_C_FB_A/RDQ67 | C | PR77B | 3 | RLM0_GPLL_C_FB_A/RDQ80 | C | |
| U23 | PR64A | 3 | RLM0_GPLL_T_FB_A/RDQ67 | T | PR77A | 3 | RLM0_GPLL_T_FB_A/RDQ80 | T | |
| U24 | PR63B | 3 | RLM0_GPLL_C_IN_A**/RDQ67 | C (LVDS)* | PR76B | 3 | RLM0_GPLL_C_IN_A**/RDQ80 | C (LVDS)* | |
| U25 | PR63A | 3 | RLM0_GPLL_T_IN_A**/RDQ67 | T (LVDS)* | PR76A | 3 | RLM0_GPLL_T_IN_A**/RDQ80 | T (LVDS)* | |
| R20 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | | |
| P18 | VCCPLL | 3 | | | VCCPLL | - | | | |
| T19 | PR61B | 3 | RLM0_GDLL_C_FB_A/RDQ58 | C | PR74B | 3 | RLM0_GDLL_C_FB_A/RDQ71 | C | |
| U20 | PR61A | 3 | RLM0_GDLL_T_FB_A/RDQ58 | T | PR74A | 3 | RLM0_GDLL_T_FB_A/RDQ71 | T | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| T25 | PR60B | 3 | RLM0_GDLL_C_IN_A**/RDQ58 | C (LVDS)* | PR73B | 3 | RLM0_GDLL_C_IN_A**/RDQ71 | C (LVDS)* | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | | |
|-------------|-------------------|------|-------------------------|--------------|-------------------|------|-------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| T26 | PR60A | 3 | RLM0_GDLLT_IN_A**/RDQ58 | T (LVDS)* | PR73A | 3 | RLM0_GDLLT_IN_A**/RDQ71 | T (LVDS)* | |
| T20 | PR59B | 3 | RDQ58 | C | PR72B | 3 | RDQ71 | C | |
| T22 | PR59A | 3 | RDQ58 | T | PR72A | 3 | RDQ71 | T | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| R26 | PR58B | 3 | RDQ58 | C (LVDS)* | PR71B | 3 | RDQ71 | C (LVDS)* | |
| R25 | PR58A | 3 | RDQS58 | T (LVDS)* | PR71A | 3 | RDQS71 | T (LVDS)* | |
| R22 | PR57B | 3 | RDQ58 | C | PR70B | 3 | RDQ71 | C | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| T21 | PR57A | 3 | RDQ58 | T | PR70A | 3 | RDQ71 | T | |
| P26 | PR56B | 3 | RDQ58 | C (LVDS)* | PR69B | 3 | RDQ71 | C (LVDS)* | |
| P25 | PR56A | 3 | RDQ58 | T (LVDS)* | PR69A | 3 | RDQ71 | T (LVDS)* | |
| R24 | PR55B | 3 | RDQ58 | C | PR68B | 3 | RDQ71 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| R23 | PR55A | 3 | RDQ58 | T | PR68A | 3 | RDQ71 | T | |
| P20 | PR54B | 3 | RDQ58 | C (LVDS)* | PR67B | 3 | RDQ71 | C (LVDS)* | |
| R19 | PR54A | 3 | RDQ58 | T (LVDS)* | PR67A | 3 | RDQ71 | T (LVDS)* | |
| P21 | PR53B | 3 | RDQ50 | C | PR66B | 3 | RDQ63 | C | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| P19 | PR53A | 3 | RDQ50 | T | PR66A | 3 | RDQ63 | T | |
| P23 | PR52B | 3 | RDQ50 | C (LVDS)* | PR65B | 3 | RDQ63 | C (LVDS)* | |
| P22 | PR52A | 3 | RDQ50 | T (LVDS)* | PR65A | 3 | RDQ63 | T (LVDS)* | |
| N22 | PR51B | 3 | RDQ50 | C | PR64B | 3 | RDQ63 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| R21 | PR51A | 3 | RDQ50 | T | PR64A | 3 | RDQ63 | T | |
| N26 | PR50B | 3 | RDQ50 | C (LVDS)* | PR63B | 3 | RDQ63 | C (LVDS)* | |
| N25 | PR50A | 3 | RDQS50 | T (LVDS)* | PR63A | 3 | RDQS63 | T (LVDS)* | |
| GND | GNDIO3 | - | | | GNDIO3 | - | | | |
| N19 | PR49B | 3 | RDQ50 | C | PR62B | 3 | RDQ63 | C | |
| N20 | PR49A | 3 | RDQ50 | T | PR62A | 3 | RDQ63 | T | |
| M26 | PR48B | 3 | RDQ50 | C (LVDS)* | PR61B | 3 | RDQ63 | C (LVDS)* | |
| M25 | PR48A | 3 | RDQ50 | T (LVDS)* | PR61A | 3 | RDQ63 | T (LVDS)* | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| N18 | PR47B | 3 | VREF2_3/RDQ50 | C | PR60B | 3 | VREF2_3/RDQ63 | C | |
| N21 | PR47A | 3 | VREF1_3/RDQ50 | T | PR60A | 3 | VREF1_3/RDQ63 | T | |
| L26 | PR46B | 3 | PCLKC3_0/RDQ50 | C (LVDS)* | PR59B | 3 | PCLKC3_0/RDQ63 | C (LVDS)* | |
| L25 | PR46A | 3 | PCLKT3_0/RDQ50 | T (LVDS)* | PR59A | 3 | PCLKT3_0/RDQ63 | T (LVDS)* | |
| N24 | PR44B | 2 | PCLKC2_0/RDQ41 | C | PR57B | 2 | PCLKC2_0/RDQ54 | C | |
| M23 | PR44A | 2 | PCLKT2_0/RDQ41 | T | PR57A | 2 | PCLKT2_0/RDQ54 | T | |
| GND | GNDIO2 | - | | | GNDIO2 | - | | | |
| L21 | PR43B | 2 | RDQ41 | C (LVDS)* | PR56B | 2 | RDQ54 | C (LVDS)* | |
| K22 | PR43A | 2 | RDQ41 | T (LVDS)* | PR56A | 2 | RDQ54 | T (LVDS)* | |
| M24 | PR42B | 2 | RDQ41 | C | PR55B | 2 | RDQ54 | C | |
| N23 | PR42A | 2 | RDQ41 | T | PR55A | 2 | RDQ54 | T | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| K26 | PR41B | 2 | RDQ41 | C (LVDS)* | PR54B | 2 | RDQ54 | C (LVDS)* | |
| K25 | PR41A | 2 | RDQS41 | T (LVDS)* | PR54A | 2 | RDQS54 | T (LVDS)* | |
| M20 | PR40B | 2 | RDQ41 | C | PR53B | 2 | RDQ54 | C | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| M19 | PR40A | 2 | RDQ41 | T | PR53A | 2 | RDQ54 | T |
| L22 | PR39B | 2 | RDQ41 | C (LVDS)* | PR52B | 2 | RDQ54 | C (LVDS)* |
| M22 | PR39A | 2 | RDQ41 | T (LVDS)* | PR52A | 2 | RDQ54 | T (LVDS)* |
| K21 | PR38B | 2 | RDQ41 | C | PR51B | 2 | RDQ54 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M21 | PR38A | 2 | RDQ41 | T | PR51A | 2 | RDQ54 | T |
| K24 | PR37B | 2 | RDQ41 | C (LVDS)* | PR50B | 2 | RDQ54 | C (LVDS)* |
| J24 | PR37A | 2 | RDQ41 | T (LVDS)* | PR50A | 2 | RDQ54 | T (LVDS)* |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L20 | VCCPLL | 2 | | | NC | - | | |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| J26 | PR26B | 2 | RUM0_SPLLC_FB_A/RDQ24 | C | PR39B | 2 | RUM0_SPLLC_FB_A/RDQ37 | C |
| J25 | PR26A | 2 | RUM0_SPLLT_FB_A/RDQ24 | T | PR39A | 2 | RUM0_SPLLT_FB_A/RDQ37 | T |
| J23 | PR25B | 2 | RUM0_SPLLC_IN_A/RDQ24 | C | PR38B | 2 | RUM0_SPLLC_IN_A/RDQ37 | C |
| K23 | PR25A | 2 | RUM0_SPLLT_IN_A/RDQ24 | T | PR38A | 2 | RUM0_SPLLT_IN_A/RDQ37 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H26 | PR24B | 2 | RDQ24 | C (LVDS)* | PR37B | 2 | RDQ37 | C (LVDS)* |
| H25 | PR24A | 2 | RDQS24*** | T (LVDS)* | PR37A | 2 | RDQS37*** | T (LVDS)* |
| H24 | PR23B | 2 | RDQ24 | C | PR36B | 2 | RDQ37 | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| H23 | PR23A | 2 | RDQ24 | T | PR36A | 2 | RDQ37 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| G26 | PR19B | 2 | RDQ16 | C | PR32B | 2 | RDQ29 | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| G25 | PR19A | 2 | RDQ16 | T | PR32A | 2 | RDQ29 | T |
| F26 | PR18B | 2 | RDQ16 | C (LVDS)* | PR31B | 2 | RDQ29 | C (LVDS)* |
| F25 | PR18A | 2 | RDQ16 | T (LVDS)* | PR31A | 2 | RDQ29 | T (LVDS)* |
| K20 | PR17B | 2 | RDQ16 | C | PR30B | 2 | RDQ29 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L19 | PR17A | 2 | RDQ16 | T | PR30A | 2 | RDQ29 | T |
| E26 | PR16B | 2 | RDQ16 | C (LVDS)* | PR29B | 2 | RDQ29 | C (LVDS)* |
| E25 | PR16A | 2 | RDQS16 | T (LVDS)* | PR29A | 2 | RDQS29 | T (LVDS)* |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| J22 | PR15B | 2 | RDQ16 | C | PR28B | 2 | RDQ29 | C |
| H22 | PR15A | 2 | RDQ16 | T | PR28A | 2 | RDQ29 | T |
| G24 | PR14B | 2 | RDQ16 | C (LVDS)* | PR27B | 2 | RDQ29 | C (LVDS)* |
| G23 | PR14A | 2 | RDQ16 | T (LVDS)* | PR27A | 2 | RDQ29 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K19 | PR13B | 2 | RDQ16 | C | PR26B | 2 | RDQ29 | C |
| J19 | PR13A | 2 | RDQ16 | T | PR26A | 2 | RDQ29 | T |
| D26 | PR12B | 2 | RDQ16 | C (LVDS)* | PR25B | 2 | RDQ29 | C (LVDS)* |
| C26 | PR12A | 2 | RDQ16 | T (LVDS)* | PR25A | 2 | RDQ29 | T (LVDS)* |
| F22 | PR11B | 2 | RDQ8 | C | PR24B | 2 | RDQ21 | C |
| E24 | PR11A | 2 | RDQ8 | T | PR24A | 2 | RDQ21 | T |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D25 | PR10B | 2 | RDQ8 | C (LVDS)* | PR23B | 2 | RDQ21 | C (LVDS)* |
| C25 | PR10A | 2 | RDQ8 | T (LVDS)* | PR23A | 2 | RDQ21 | T (LVDS)* |
| D24 | PR9B | 2 | RDQ8 | C | PR22B | 2 | RDQ21 | C |
| B25 | PR9A | 2 | RDQ8 | T | PR22A | 2 | RDQ21 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H21 | PR8B | 2 | RDQ8 | C (LVDS)* | PR21B | 2 | RDQ21 | C (LVDS)* |
| G22 | PR8A | 2 | RDQS8 | T (LVDS)* | PR21A | 2 | RDQS21 | T (LVDS)* |
| B24 | PR7B | 2 | RDQ8 | C | PR20B | 2 | RDQ21 | C |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| C24 | PR7A | 2 | RDQ8 | T | PR20A | 2 | RDQ21 | T |
| D23 | PR6B | 2 | RDQ8 | C (LVDS)* | PR19B | 2 | RDQ21 | C (LVDS)* |
| C23 | PR6A | 2 | RDQ8 | T (LVDS)* | PR19A | 2 | RDQ21 | T (LVDS)* |
| G21 | PR5B | 2 | RDQ8 | C | PR18B | 2 | RDQ21 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H20 | PR5A | 2 | RDQ8 | T | PR18A | 2 | RDQ21 | T |
| GND | GNDIO2 | - | | | GNDIO2 | - | | |
| E22 | PR2B | 2 | VREF2_2 | C (LVDS)* | PR2B | 2 | VREF2_2 | C (LVDS)* |
| F21 | PR2A | 2 | VREF1_2 | T (LVDS)* | PR2A | 2 | VREF1_2 | T (LVDS)* |
| E23 | PT82B | 1 | VREF2_1 | C | PT100B | 1 | VREF2_1 | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| D22 | PT82A | 1 | VREF1_1 | T | PT100A | 1 | VREF1_1 | T |
| G20 | PT81B | 1 | | C | PT99B | 1 | | C |
| J18 | PT81A | 1 | | T | PT99A | 1 | | T |
| F20 | PT80B | 1 | | C | PT98B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H19 | PT80A | 1 | | T | PT98A | 1 | | T |
| A24 | PT79B | 1 | | C | PT97B | 1 | | C |
| A23 | PT79A | 1 | | T | PT97A | 1 | | T |
| E21 | PT78B | 1 | | C | PT96B | 1 | | C |
| F19 | PT78A | 1 | | T | PT96A | 1 | | T |
| C22 | PT77B | 1 | | C | PT95B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| E20 | PT77A | 1 | | T | PT95A | 1 | | T |
| B22 | PT76B | 1 | | C | PT94B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| B23 | PT76A | 1 | | T | PT94A | 1 | | T |
| C20 | PT75B | 1 | | C | PT93B | 1 | | C |
| D20 | PT75A | 1 | | T | PT93A | 1 | | T |
| A22 | PT74B | 1 | | C | PT92B | 1 | | C |
| A21 | PT74A | 1 | | T | PT92A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| E19 | PT71B | 1 | | C | PT85B | 1 | | C |
| C19 | PT71A | 1 | | T | PT85A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| B21 | PT70B | 1 | | C | PT79B | 1 | | C |
| B20 | PT70A | 1 | | T | PT79A | 1 | | T |
| D19 | PT69B | 1 | | C | PT78B | 1 | | C |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| B19 | PT69A | 1 | | T | PT78A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| G17 | PT68B | 1 | | C | PT77B | 1 | | C |
| E18 | PT68A | 1 | | T | PT77A | 1 | | T |
| G19 | PT67B | 1 | | C | PT76B | 1 | | C |
| F17 | PT67A | 1 | | T | PT76A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A20 | PT66B | 1 | | C | PT75B | 1 | | C |
| A19 | PT66A | 1 | | T | PT75A | 1 | | T |
| E17 | PT65B | 1 | | C | PT74B | 1 | | C |
| D18 | PT65A | 1 | | T | PT74A | 1 | | T |
| B18 | PT64B | 1 | | C | PT73B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| A18 | PT64A | 1 | | T | PT73A | 1 | | T |
| E16 | PT63B | 1 | | C | PT72B | 1 | | C |
| G16 | PT63A | 1 | | T | PT72A | 1 | | T |
| F16 | PT62B | 1 | | C | PT71B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H18 | PT62A | 1 | | T | PT71A | 1 | | T |
| A17 | PT61B | 1 | | C | PT70B | 1 | | C |
| B17 | PT61A | 1 | | T | PT70A | 1 | | T |
| C18 | PT60B | 1 | | C | PT69B | 1 | | C |
| B16 | PT60A | 1 | | T | PT69A | 1 | | T |
| C17 | PT59B | 1 | | C | PT68B | 1 | | C |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| D17 | PT59A | 1 | | T | PT68A | 1 | | T |
| E15 | PT58B | 1 | | C | PT67B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G15 | PT58A | 1 | | T | PT67A | 1 | | T |
| A16 | PT57B | 1 | | C | PT66B | 1 | | C |
| B15 | PT57A | 1 | | T | PT66A | 1 | | T |
| D15 | PT56B | 1 | | C | PT65B | 1 | | C |
| F15 | PT56A | 1 | | T | PT65A | 1 | | T |
| A14 | PT55B | 1 | | C | PT64B | 1 | | C |
| B14 | PT55A | 1 | | T | PT64A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| C15 | PT54B | 1 | | C | PT63B | 1 | | C |
| A15 | PT54A | 1 | | T | PT63A | 1 | | T |
| A13 | PT53B | 1 | | C | PT62B | 1 | | C |
| B13 | PT53A | 1 | | T | PT62A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H17 | PT52B | 1 | | C | PT61B | 1 | | C |
| H15 | PT52A | 1 | | T | PT61A | 1 | | T |
| D13 | PT51B | 1 | | C | PT60B | 1 | | C |
| C14 | PT51A | 1 | | T | PT60A | 1 | | T |
| GND | GNDIO1 | - | | | GNDIO1 | - | | |
| G14 | PT50B | 1 | | C | PT59B | 1 | | C |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E14 | PT50A | 1 | | T | PT59A | 1 | | T |
| A12 | PT49B | 1 | | C | PT58B | 1 | | C |
| B12 | PT49A | 1 | | T | PT58A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F14 | PT48B | 1 | PCLKC1_0 | C | PT57B | 1 | PCLKC1_0 | C |
| D14 | PT48A | 1 | PCLKT1_0 | T | PT57A | 1 | PCLKT1_0 | T |
| H16 | XRES | 1 | | | XRES | 1 | | |
| H14 | PT46B | 0 | PCLKC0_0 | C | PT55B | 0 | PCLKC0_0 | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| H13 | PT46A | 0 | PCLKT0_0 | T | PT55A | 0 | PCLKT0_0 | T |
| A11 | PT45B | 0 | | C | PT54B | 0 | | C |
| B11 | PT45A | 0 | | T | PT54A | 0 | | T |
| C13 | PT44B | 0 | | C | PT53B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E13 | PT44A | 0 | | T | PT53A | 0 | | T |
| D12 | PT43B | 0 | | C | PT52B | 0 | | C |
| F13 | PT43A | 0 | | T | PT52A | 0 | | T |
| A10 | PT42B | 0 | | C | PT51B | 0 | | C |
| B10 | PT42A | 0 | | T | PT51A | 0 | | T |
| C12 | PT41B | 0 | | C | PT50B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| C10 | PT41A | 0 | | T | PT50A | 0 | | T |
| G13 | PT40B | 0 | | C | PT49B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H12 | PT40A | 0 | | T | PT49A | 0 | | T |
| A9 | PT39B | 0 | | C | PT48B | 0 | | C |
| B9 | PT39A | 0 | | T | PT48A | 0 | | T |
| E12 | PT38B | 0 | | C | PT47B | 0 | | C |
| G12 | PT38A | 0 | | T | PT47A | 0 | | T |
| A8 | PT37B | 0 | | C | PT46B | 0 | | C |
| B8 | PT37A | 0 | | T | PT46A | 0 | | T |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| E11 | PT36B | 0 | | C | PT45B | 0 | | C |
| C9 | PT36A | 0 | | T | PT45A | 0 | | T |
| A7 | PT35B | 0 | | C | PT44B | 0 | | C |
| B7 | PT35A | 0 | | T | PT44A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F12 | PT34B | 0 | | C | PT43B | 0 | | C |
| D10 | PT34A | 0 | | T | PT43A | 0 | | T |
| H11 | PT33B | 0 | | C | PT42B | 0 | | C |
| G11 | PT33A | 0 | | T | PT42A | 0 | | T |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| A6 | PT32B | 0 | | C | PT41B | 0 | | C |
| B6 | PT32A | 0 | | T | PT41A | 0 | | T |
| D8 | PT31B | 0 | | C | PT40B | 0 | | C |
| C8 | PT31A | 0 | | T | PT40A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F11 | PT30B | 0 | | C | PT39B | 0 | | C |
| E10 | PT30A | 0 | | T | PT39A | 0 | | T |
| E9 | PT29B | 0 | | C | PT38B | 0 | | C |
| D9 | PT29A | 0 | | T | PT38A | 0 | | T |
| G10 | PT28B | 0 | | C | PT37B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| H10 | PT28A | 0 | | T | PT37A | 0 | | T |
| A5 | PT27B | 0 | | C | PT36B | 0 | | C |
| B5 | PT27A | 0 | | T | PT36A | 0 | | T |
| C7 | PT26B | 0 | | C | PT35B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D7 | PT26A | 0 | | T | PT35A | 0 | | T |
| E8 | PT25B | 0 | | C | PT34B | 0 | | C |
| F10 | PT25A | 0 | | T | PT34A | 0 | | T |
| F8 | PT24B | 0 | | C | PT33B | 0 | | C |
| H9 | PT24A | 0 | | T | PT33A | 0 | | T |
| C5 | PT23B | 0 | | C | PT32B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| D5 | PT23A | 0 | | T | PT32A | 0 | | T |
| B4 | PT22B | 0 | | | PT31B | 0 | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C4 | PT10B | 0 | | C | PT10B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| C3 | PT10A | 0 | | T | PT10A | 0 | | T |
| A4 | PT9B | 0 | | C | PT9B | 0 | | C |
| A3 | PT9A | 0 | | T | PT9A | 0 | | T |
| B3 | PT8B | 0 | | C | PT8B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| B2 | PT8A | 0 | | T | PT8A | 0 | | T |
| D4 | PT7B | 0 | | C | PT7B | 0 | | C |
| D3 | PT7A | 0 | | T | PT7A | 0 | | T |
| C2 | PT6B | 0 | | C | PT6B | 0 | | C |
| C1 | PT6A | 0 | | T | PT6A | 0 | | T |
| G8 | PT5B | 0 | | C | PT5B | 0 | | C |
| GND | GNDIO0 | - | | | GNDIO0 | - | | |
| G7 | PT5A | 0 | | T | PT5A | 0 | | T |
| E7 | PT4B | 0 | | C | PT4B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F7 | PT4A | 0 | | T | PT4A | 0 | | T |
| E6 | PT3B | 0 | | C | PT3B | 0 | | C |
| E5 | PT3A | 0 | | T | PT3A | 0 | | T |
| G6 | PT2B | 0 | VREF2_0 | C | PT2B | 0 | VREF2_0 | C |
| G5 | PT2A | 0 | VREF1_0 | T | PT2A | 0 | VREF1_0 | T |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| L12 | VCC | - | | | VCC | - | | |
| L13 | VCC | - | | | VCC | - | | |
| L14 | VCC | - | | | VCC | - | | |
| L15 | VCC | - | | | VCC | - | | |
| M11 | VCC | - | | | VCC | - | | |
| M12 | VCC | - | | | VCC | - | | |
| M15 | VCC | - | | | VCC | - | | |
| M16 | VCC | - | | | VCC | - | | |
| N11 | VCC | - | | | VCC | - | | |
| N16 | VCC | - | | | VCC | - | | |
| P11 | VCC | - | | | VCC | - | | |
| P16 | VCC | - | | | VCC | - | | |
| R11 | VCC | - | | | VCC | - | | |
| R12 | VCC | - | | | VCC | - | | |
| R15 | VCC | - | | | VCC | - | | |
| R16 | VCC | - | | | VCC | - | | |
| T12 | VCC | - | | | VCC | - | | |
| T13 | VCC | - | | | VCC | - | | |
| T14 | VCC | - | | | VCC | - | | |
| T15 | VCC | - | | | VCC | - | | |
| D11 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D6 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| K12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| J12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D16 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D21 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G18 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| J15 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| K15 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F23 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J20 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L23 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M17 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M18 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| AA23 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R17 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R18 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| T23 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| V20 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AC16 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC21 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| U15 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| V15 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| Y18 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC11 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AC6 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| U12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| V12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| Y9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA4 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R10 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R9 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| T4 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| F4 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L4 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M9 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| AE25 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| V18 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| J10 | VCCAUX | - | | | VCCAUX | - | | |
| J11 | VCCAUX | - | | | VCCAUX | - | | |
| J16 | VCCAUX | - | | | VCCAUX | - | | |
| J17 | VCCAUX | - | | | VCCAUX | - | | |
| K18 | VCCAUX | - | | | VCCAUX | - | | |
| K9 | VCCAUX | - | | | VCCAUX | - | | |
| L18 | VCCAUX | - | | | VCCAUX | - | | |
| L9 | VCCAUX | - | | | VCCAUX | - | | |
| T18 | VCCAUX | - | | | VCCAUX | - | | |
| T9 | VCCAUX | - | | | VCCAUX | - | | |
| U18 | VCCAUX | - | | | VCCAUX | - | | |
| U9 | VCCAUX | - | | | VCCAUX | - | | |
| V10 | VCCAUX | - | | | VCCAUX | - | | |
| V11 | VCCAUX | - | | | VCCAUX | - | | |
| V16 | VCCAUX | - | | | VCCAUX | - | | |
| V17 | VCCAUX | - | | | VCCAUX | - | | |
| A2 | GND | - | | | GND | - | | |
| A25 | GND | - | | | GND | - | | |
| AA18 | GND | - | | | GND | - | | |
| AA24 | GND | - | | | GND | - | | |
| AA3 | GND | - | | | GND | - | | |
| AA9 | GND | - | | | GND | - | | |
| AD11 | GND | - | | | GND | - | | |
| AD16 | GND | - | | | GND | - | | |
| AD21 | GND | - | | | GND | - | | |
| AD6 | GND | - | | | GND | - | | |
| AE1 | GND | - | | | GND | - | | |
| AE26 | GND | - | | | GND | - | | |
| AF2 | GND | - | | | GND | - | | |
| AF25 | GND | - | | | GND | - | | |
| B1 | GND | - | | | GND | - | | |
| B26 | GND | - | | | GND | - | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| C11 | GND | - | | | GND | - | | |
| C16 | GND | - | | | GND | - | | |
| C21 | GND | - | | | GND | - | | |
| C6 | GND | - | | | GND | - | | |
| F18 | GND | - | | | GND | - | | |
| F24 | GND | - | | | GND | - | | |
| F3 | GND | - | | | GND | - | | |
| F9 | GND | - | | | GND | - | | |
| J13 | GND | - | | | GND | - | | |
| J14 | GND | - | | | GND | - | | |
| J21 | GND | - | | | GND | - | | |
| J6 | GND | - | | | GND | - | | |
| K10 | GND | - | | | GND | - | | |
| K11 | GND | - | | | GND | - | | |
| K13 | GND | - | | | GND | - | | |
| K14 | GND | - | | | GND | - | | |
| K16 | GND | - | | | GND | - | | |
| K17 | GND | - | | | GND | - | | |
| L10 | GND | - | | | GND | - | | |
| L11 | GND | - | | | GND | - | | |
| L16 | GND | - | | | GND | - | | |
| L17 | GND | - | | | GND | - | | |
| L24 | GND | - | | | GND | - | | |
| L3 | GND | - | | | GND | - | | |
| M13 | GND | - | | | GND | - | | |
| M14 | GND | - | | | GND | - | | |
| N10 | GND | - | | | GND | - | | |
| N12 | GND | - | | | GND | - | | |
| N13 | GND | - | | | GND | - | | |
| N14 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N17 | GND | - | | | GND | - | | |
| P10 | GND | - | | | GND | - | | |
| P12 | GND | - | | | GND | - | | |
| P13 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P15 | GND | - | | | GND | - | | |
| P17 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| R14 | GND | - | | | GND | - | | |
| T10 | GND | - | | | GND | - | | |
| T11 | GND | - | | | GND | - | | |
| T16 | GND | - | | | GND | - | | |
| T17 | GND | - | | | GND | - | | |
| T24 | GND | - | | | GND | - | | |
| T3 | GND | - | | | GND | - | | |
| U10 | GND | - | | | GND | - | | |

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

| LFE2-50E/SE | | | | | LFE2-70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| U11 | GND | - | | | GND | - | | |
| U13 | GND | - | | | GND | - | | |
| U14 | GND | - | | | GND | - | | |
| U16 | GND | - | | | GND | - | | |
| U17 | GND | - | | | GND | - | | |
| V13 | GND | - | | | GND | - | | |
| V14 | GND | - | | | GND | - | | |
| V21 | GND | - | | | GND | - | | |
| V6 | GND | - | | | GND | - | | |
| M3 | NC | - | | | NC | - | | |
| N6 | NC | - | | | NC | - | | |
| P24 | NC | - | | | NC | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO7 | 7 | | |
| F4 | PL2A | 7 | VREF2_7 | T (LVDS)* |
| F3 | PL2B | 7 | VREF1_7 | C (LVDS)* |
| H4 | PL3A | 7 | | T |
| G5 | PL3B | 7 | | C |
| GND | GNDIO7 | - | | |
| D2 | PL4A | 7 | | T (LVDS)* |
| D1 | PL4B | 7 | | C (LVDS)* |
| E2 | PL5A | 7 | | T |
| VCCIO | VCCIO7 | 7 | | |
| E1 | PL5B | 7 | | C |
| GND | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | |
| F1 | PL14A | 7 | LUM1_SPLLT_IN_A/LDQ12 | T (LVDS)* |
| F2 | PL14B | 7 | LUM1_SPLLC_IN_A/LDQ12 | C (LVDS)* |
| G1 | PL15A | 7 | LUM1_SPLLT_FB_A/LDQ12 | T |
| G2 | PL15B | 7 | LUM1_SPLLC_FB_A/LDQ12 | C |
| GND | GNDIO7 | - | | |
| H8 | PL18A | 7 | LDQ21 | T |
| H6 | PL18B | 7 | LDQ21 | C |
| VCCIO | VCCIO7 | 7 | | |
| G4 | PL19A | 7 | LDQ21 | T (LVDS)* |
| G3 | PL19B | 7 | LDQ21 | C (LVDS)* |
| H7 | PL20A | 7 | LDQ21 | T |
| H5 | PL20B | 7 | LDQ21 | C |
| GND | GNDIO7 | - | | |
| H2 | PL21A | 7 | LDQS21 | T (LVDS)* |
| H1 | PL21B | 7 | LDQ21 | C (LVDS)* |
| J6 | PL22A | 7 | LDQ21 | T |
| VCCIO | VCCIO7 | 7 | | |
| J8 | PL22B | 7 | LDQ21 | C |
| J2 | PL23A | 7 | LDQ21 | T (LVDS)* |
| J1 | PL23B | 7 | LDQ21 | C (LVDS)* |
| J5 | PL24A | 7 | LDQ21 | T |
| GND | GNDIO7 | - | | |
| J7 | PL24B | 7 | LDQ21 | C |
| J4 | PL25A | 7 | LDQ29 | T (LVDS)* |
| J3 | PL25B | 7 | LDQ29 | C (LVDS)* |
| K6 | PL26A | 7 | LDQ29 | T |
| K8 | PL26B | 7 | LDQ29 | C |
| VCCIO | VCCIO7 | 7 | | |
| K2 | PL27A | 7 | LDQ29 | T (LVDS)* |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| K1 | PL27B | 7 | LDQ29 | C (LVDS)* |
| K5 | PL28A | 7 | LDQ29 | T |
| K7 | PL28B | 7 | LDQ29 | C |
| GND | GNDIO7 | - | | |
| K4 | PL29A | 7 | LDQS29 | T (LVDS)* |
| K3 | PL29B | 7 | LDQ29 | C (LVDS)* |
| L8 | PL30A | 7 | LDQ29 | T |
| VCCIO | VCCIO7 | 7 | | |
| L6 | PL30B | 7 | LDQ29 | C |
| L2 | PL31A | 7 | LDQ29 | T (LVDS)* |
| L1 | PL31B | 7 | LDQ29 | C (LVDS)* |
| L7 | PL32A | 7 | LDQ29 | T |
| GND | GNDIO7 | - | | |
| L5 | PL32B | 7 | LDQ29 | C |
| L4 | PL33A | 7 | LDQ37 | T (LVDS)* |
| L3 | PL33B | 7 | LDQ37 | C (LVDS)* |
| M8 | PL34A | 7 | LDQ37 | T |
| M6 | PL34B | 7 | LDQ37 | C |
| VCCIO | VCCIO7 | 7 | | |
| M2 | PL35A | 7 | LDQ37 | T (LVDS)* |
| M1 | PL35B | 7 | LDQ37 | C (LVDS)* |
| M7 | PL36A | 7 | LDQ37 | T |
| M5 | PL36B | 7 | LDQ37 | C |
| GND | GNDIO7 | - | | |
| M4 | PL37A | 7 | LDQS37 | T (LVDS)* |
| M3 | PL37B | 7 | LDQ37 | C (LVDS)* |
| N6 | PL38A | 7 | LUM0_SPLLT_IN_A/LDQ37 | T |
| VCCIO | VCCIO7 | 7 | | |
| N8 | PL38B | 7 | LUM0_SPLLC_IN_A/LDQ37 | C |
| N5 | PL39A | 7 | LUM0_SPLLT_FB_A/LDQ37 | T |
| N7 | PL39B | 7 | LUM0_SPLLC_FB_A/LDQ37 | C |
| GND | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | |
| T9 | PL50A | 7 | LDQ54 | |
| R9 | PL51A | 7 | LDQ54 | T |
| P7 | PL51B | 7 | LDQ54 | C |
| VCCIO | VCCIO7 | 7 | | |
| N2 | PL52A | 7 | LDQ54 | T (LVDS)* |
| N1 | PL52B | 7 | LDQ54 | C (LVDS)* |
| P6 | PL53A | 7 | LDQ54 | T |
| P5 | PL53B | 7 | LDQ54 | C |
| GND | GNDIO7 | - | | |
| P4 | PL54A | 7 | LDQS54 | T (LVDS)* |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| P3 | PL54B | 7 | LDQ54 | C (LVDS)* |
| R6 | PL55A | 7 | LDQ54 | T |
| VCCIO | VCCIO7 | 7 | | |
| R8 | PL55B | 7 | LDQ54 | C |
| P2 | PL56A | 7 | LDQ54 | T (LVDS)* |
| P1 | PL56B | 7 | LDQ54 | C (LVDS)* |
| R5 | PL57A | 7 | PCLKT7_0/LDQ54 | T |
| GND | GNDIO7 | - | | |
| R7 | PL57B | 7 | PCLKC7_0/LDQ54 | C |
| R4 | PL59A | 6 | PCLKT6_0/LDQ63 | T (LVDS)* |
| R3 | PL59B | 6 | PCLKC6_0/LDQ63 | C (LVDS)* |
| T5 | PL60A | 6 | VREF2_6/LDQ63 | T |
| T7 | PL60B | 6 | VREF1_6/LDQ63 | C |
| T3 | PL61A | 6 | LDQ63 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | |
| T4 | PL61B | 6 | LDQ63 | C (LVDS)* |
| T6 | PL62A | 6 | LDQ63 | T |
| T8 | PL62B | 6 | LDQ63 | C |
| T2 | PL63A | 6 | LDQS63 | T (LVDS)* |
| GND | GNDIO6 | - | | |
| T1 | PL63B | 6 | LDQ63 | C (LVDS)* |
| U7 | PL64A | 6 | LDQ63 | T |
| U5 | PL64B | 6 | LDQ63 | C |
| VCCIO | VCCIO6 | 6 | | |
| U4 | PL65A | 6 | LDQ63 | T (LVDS)* |
| U3 | PL65B | 6 | LDQ63 | C (LVDS)* |
| U8 | PL66A | 6 | LDQ63 | T |
| U6 | PL66B | 6 | LDQ63 | C |
| GND | GNDIO6 | - | | |
| U2 | PL67A | 6 | LDQ71 | T (LVDS)* |
| U1 | PL67B | 6 | LDQ71 | C (LVDS)* |
| V7 | PL68A | 6 | LDQ71 | T |
| V5 | PL68B | 6 | LDQ71 | C |
| VCCIO | VCCIO6 | 6 | | |
| V2 | PL69A | 6 | LDQ71 | T (LVDS)* |
| V1 | PL69B | 6 | LDQ71 | C (LVDS)* |
| V8 | PL70A | 6 | LDQ71 | T |
| V6 | PL70B | 6 | LDQ71 | C |
| GND | GNDIO6 | - | | |
| W1 | PL71A | 6 | LDQS71 | T (LVDS)* |
| W2 | PL71B | 6 | LDQ71 | C (LVDS)* |
| W5 | PL72A | 6 | LDQ71 | T |
| VCCIO | VCCIO6 | 6 | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|-------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| W7 | PL72B | 6 | LDQ71 | C |
| W4 | PL73A | 6 | LLM0_GDLLT_IN_A**/LDQ71 | T (LVDS)* |
| W3 | PL73B | 6 | LLM0_GDLLC_IN_A**/LDQ71 | C (LVDS)* |
| W6 | PL74A | 6 | LLM0_GDLLT_FB_A/LDQ71 | T |
| GND | GNDIO6 | - | | |
| W8 | PL74B | 6 | LLM0_GDLLC_FB_D/LDQ71 | C |
| Y8 | LLM0_PLLCAP | 6 | | |
| Y1 | PL76A | 6 | LLM0_GPLLT_IN_A**/LDQ80 | T (LVDS)* |
| Y2 | PL76B | 6 | LLM0_GPLLC_IN_A**/LDQ80 | C (LVDS)* |
| Y5 | PL77A | 6 | LLM0_GPLLT_FB_A/LDQ80 | T |
| Y6 | PL77B | 6 | LLM0_GPLLC_FB_A/LDQ80 | C |
| Y4 | PL78A | 6 | LDQ80 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | |
| Y3 | PL78B | 6 | LDQ80 | C (LVDS)* |
| AA6 | PL79A | 6 | LDQ80 | T |
| AA8 | PL79B | 6 | LDQ80 | C |
| AA2 | PL80A | 6 | LDQS80 | T (LVDS)* |
| GND | GNDIO6 | - | | |
| AA1 | PL80B | 6 | LDQ80 | C (LVDS)* |
| AA7 | PL81A | 6 | LDQ80 | T |
| AA5 | PL81B | 6 | LDQ80 | C |
| VCCIO | VCCIO6 | 6 | | |
| AA4 | PL82A | 6 | LDQ80 | T (LVDS)* |
| AA3 | PL82B | 6 | LDQ80 | C (LVDS)* |
| AB7 | PL83A | 6 | LDQ80 | T |
| AB5 | PL83B | 6 | LDQ80 | C |
| GND | GNDIO6 | - | | |
| AB2 | PL84A | 6 | LDQ88 | T (LVDS)* |
| AB1 | PL84B | 6 | LDQ88 | C (LVDS)* |
| AB8 | PL85A | 6 | LDQ88 | T |
| AB6 | PL85B | 6 | LDQ88 | C |
| VCCIO | VCCIO6 | 6 | | |
| AB4 | PL86A | 6 | LDQ88 | T (LVDS)* |
| AB3 | PL86B | 6 | LDQ88 | C (LVDS)* |
| AC7 | PL87A | 6 | LDQ88 | T |
| AC5 | PL87B | 6 | LDQ88 | C |
| GND | GNDIO6 | - | | |
| AC2 | PL88A | 6 | LDQS88 | T (LVDS)* |
| AC1 | PL88B | 6 | LDQ88 | C (LVDS)* |
| AC6 | PL89A | 6 | LDQ88 | T |
| VCCIO | VCCIO6 | 6 | | |
| AD6 | PL89B | 6 | LDQ88 | C |
| AD1 | PL90A | 6 | LDQ88 | T (LVDS)* |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AD2 | PL90B | 6 | LDQ88 | C (LVDS)* |
| AD7 | PL91A | 6 | LDQ88 | T |
| GND | GNDIO6 | - | | |
| AB9 | PL91B | 6 | LDQ88 | C |
| AD5 | TCK | - | | |
| AE7 | TDI | - | | |
| AD4 | TMS | - | | |
| AA9 | TDO | - | | |
| AD3 | VCCJ | - | | |
| AC8 | PB2A | 5 | VREF2_5/BDQ6 | T |
| AE8 | PB2B | 5 | VREF1_5/BDQ6 | C |
| AD8 | PB3A | 5 | BDQ6 | T |
| AF8 | PB3B | 5 | BDQ6 | C |
| AG7 | PB4A | 5 | BDQ6 | T |
| VCCIO | VCCIO5 | 5 | | |
| AH7 | PB4B | 5 | BDQ6 | C |
| AC9 | PB5A | 5 | BDQ6 | T |
| AE9 | PB5B | 5 | BDQ6 | C |
| AD9 | PB6A | 5 | BDQS6 | T |
| GND | GNDIO5 | - | | |
| AF9 | PB6B | 5 | BDQ6 | C |
| AB10 | PB7A | 5 | BDQ6 | T |
| AA10 | PB7B | 5 | BDQ6 | C |
| AJ7 | PB8A | 5 | BDQ6 | T |
| VCCIO | VCCIO5 | 5 | | |
| AK7 | PB8B | 5 | BDQ6 | C |
| AC10 | PB9A | 5 | BDQ6 | T |
| AE10 | PB9B | 5 | BDQ6 | C |
| AJ8 | PB10A | 5 | BDQ6 | T |
| GND | GNDIO5 | - | | |
| AK8 | PB10B | 5 | BDQ6 | C |
| AF6 | PB11A | 5 | BDQ15 | T |
| AF7 | PB11B | 5 | BDQ15 | C |
| AG5 | PB12A | 5 | BDQ15 | T |
| AH5 | PB12B | 5 | BDQ15 | C |
| AG6 | PB13A | 5 | BDQ15 | T |
| AH6 | PB13B | 5 | BDQ15 | C |
| VCCIO | VCCIO5 | 5 | | |
| AJ4 | PB14A | 5 | BDQ15 | T |
| AK4 | PB14B | 5 | BDQ15 | C |
| GND | GNDIO5 | - | | |
| AJ5 | PB15A | 5 | BDQS15 | T |
| AK5 | PB15B | 5 | BDQ15 | C |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AJ6 | PB16A | 5 | BDQ15 | T |
| AK6 | PB16B | 5 | BDQ15 | C |
| VCCIO | VCCIO5 | 5 | | |
| GND | GNDIO5 | - | | |
| AD10 | PB29A | 5 | BDQ33 | T |
| AF10 | PB29B | 5 | BDQ33 | C |
| AC11 | PB30A | 5 | BDQ33 | T |
| AD11 | PB30B | 5 | BDQ33 | C |
| AG9 | PB31A | 5 | BDQ33 | T |
| AH9 | PB31B | 5 | BDQ33 | C |
| VCCIO | VCCIO5 | 99 | | |
| AE11 | PB32A | 5 | BDQ33 | T |
| AG10 | PB32B | 5 | BDQ33 | C |
| GND | GNDIO5 | - | | |
| AJ9 | PB33A | 5 | BDQS33 | T |
| AK9 | PB33B | 5 | BDQ33 | C |
| AF11 | PB34A | 5 | BDQ33 | T |
| AH10 | PB34B | 5 | BDQ33 | C |
| AC12 | PB35A | 5 | BDQ33 | T |
| AE12 | PB35B | 5 | BDQ33 | C |
| VCCIO | VCCIO5 | 5 | | |
| AD12 | PB36A | 5 | BDQ33 | T |
| AF12 | PB36B | 5 | BDQ33 | C |
| AJ10 | PB37A | 5 | BDQ33 | T |
| AK10 | PB37B | 5 | BDQ33 | C |
| GND | GNDIO5 | - | | |
| AG11 | PB38A | 5 | BDQ42 | T |
| AH11 | PB38B | 5 | BDQ42 | C |
| AE13 | PB39A | 5 | BDQ42 | T |
| AC13 | PB39B | 5 | BDQ42 | C |
| AF13 | PB40A | 5 | BDQ42 | T |
| VCCIO | VCCIO5 | 5 | | |
| AD13 | PB40B | 5 | BDQ42 | C |
| AJ11 | PB41A | 5 | BDQ42 | T |
| AK11 | PB41B | 5 | BDQ42 | C |
| AD14 | PB42A | 5 | BDQS42 | T |
| GND | GNDIO5 | - | | |
| AC14 | PB42B | 5 | BDQ42 | C |
| AG12 | PB43A | 5 | BDQ42 | T |
| AE14 | PB43B | 5 | BDQ42 | C |
| AJ12 | PB44A | 5 | BDQ42 | T |
| VCCIO | VCCIO5 | 5 | | |
| AK12 | PB44B | 5 | BDQ42 | C |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AH12 | PB45A | 5 | BDQ42 | T |
| AF14 | PB45B | 5 | BDQ42 | C |
| AJ13 | PB46A | 5 | BDQ42 | T |
| GND | GNDIO5 | - | | |
| AK13 | PB46B | 5 | BDQ42 | C |
| AB15 | PB47A | 5 | BDQ51 | T |
| AD15 | PB47B | 5 | BDQ51 | C |
| AE15 | PB48A | 5 | BDQ51 | T |
| AF15 | PB48B | 5 | BDQ51 | C |
| AG15 | PB49A | 5 | BDQ51 | T |
| AG14 | PB49B | 5 | BDQ51 | C |
| VCCIO | VCCIO5 | 5 | | |
| AH15 | PB50A | 5 | BDQ51 | T |
| AH14 | PB50B | 5 | BDQ51 | C |
| GND | GNDIO5 | - | | |
| AJ14 | PB51A | 5 | BDQS51 | T |
| AK14 | PB51B | 5 | BDQ51 | C |
| AD16 | PB52A | 5 | BDQ51 | T |
| AF16 | PB52B | 5 | BDQ51 | C |
| AJ15 | PB53A | 5 | PCLKT5_0/BDQ51 | T |
| AK15 | PB53B | 5 | PCLKC5_0/BDQ51 | C |
| VCCIO | VCCIO5 | 5 | | |
| GND | GNDIO5 | - | | |
| AE16 | PB58A | 4 | PCLKT4_0/BDQ60 | T |
| VCCIO | VCCIO4 | 4 | | |
| AC15 | PB58B | 4 | PCLKC4_0/BDQ60 | C |
| AJ16 | PB59A | 4 | BDQ60 | T |
| AK16 | PB59B | 4 | BDQ60 | C |
| AC16 | PB60A | 4 | BDQS60 | T |
| GND | GNDIO4 | - | | |
| AB16 | PB60B | 4 | BDQ60 | C |
| AH17 | PB61A | 4 | BDQ60 | T |
| AG17 | PB61B | 4 | BDQ60 | C |
| AF17 | PB62A | 4 | BDQ60 | T |
| VCCIO | VCCIO4 | 4 | | |
| AD17 | PB62B | 4 | BDQ60 | C |
| AE17 | PB63A | 4 | BDQ60 | T |
| AC17 | PB63B | 4 | BDQ60 | C |
| AJ17 | PB64A | 4 | BDQ60 | T |
| GND | GNDIO4 | - | | |
| AK17 | PB64B | 4 | BDQ60 | C |
| AK18 | PB65A | 4 | BDQ69 | T |
| AJ18 | PB65B | 4 | BDQ69 | C |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AD18 | PB66A | 4 | BDQ69 | T |
| AF18 | PB66B | 4 | BDQ69 | C |
| AC18 | PB67A | 4 | BDQ69 | T |
| AE18 | PB67B | 4 | BDQ69 | C |
| VCCIO | VCCIO4 | 4 | | |
| AG19 | PB68A | 4 | BDQ69 | T |
| AH19 | PB68B | 4 | BDQ69 | C |
| GND | GNDIO4 | - | | |
| AE19 | PB69A | 4 | BDQS69 | T |
| AF19 | PB69B | 4 | BDQ69 | C |
| AC19 | PB70A | 4 | BDQ69 | T |
| AD19 | PB70B | 4 | BDQ69 | C |
| AJ19 | PB71A | 4 | BDQ69 | T |
| AK19 | PB71B | 4 | BDQ69 | C |
| VCCIO | VCCIO4 | 4 | | |
| AF20 | PB72A | 4 | BDQ69 | T |
| AH20 | PB72B | 4 | BDQ69 | C |
| AE20 | PB73A | 4 | BDQ69 | T |
| AG20 | PB73B | 4 | BDQ69 | C |
| GND | GNDIO4 | - | | |
| AD20 | PB74A | 4 | BDQ78 | T |
| AC20 | PB74B | 4 | BDQ78 | C |
| AH21 | PB75A | 4 | BDQ78 | T |
| AF21 | PB75B | 4 | BDQ78 | C |
| AJ20 | PB76A | 4 | BDQ78 | T |
| VCCIO | VCCIO4 | 4 | | |
| AK20 | PB76B | 4 | BDQ78 | C |
| AG21 | PB77A | 4 | BDQ78 | T |
| AE21 | PB77B | 4 | BDQ78 | C |
| AD21 | PB78A | 4 | BDQS78 | T |
| GND | GNDIO4 | - | | |
| AC21 | PB78B | 4 | BDQ78 | C |
| AD22 | PB79A | 4 | BDQ78 | T |
| AB21 | PB79B | 4 | BDQ78 | C |
| AJ21 | PB80A | 4 | BDQ78 | T |
| VCCIO | VCCIO4 | 4 | | |
| AK21 | PB80B | 4 | BDQ78 | C |
| GND | GNDIO4 | - | | |
| VCCIO | VCCIO4 | 4 | | |
| AJ25 | PB87A | 4 | BDQS87*** | T |
| AK24 | PB87B | 4 | BDQ87 | C |
| AJ24 | PB88A | 4 | BDQ87 | T |
| AK25 | PB88B | 4 | BDQ87 | C |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AH24 | PB89A | 4 | BDQ87 | T |
| AH25 | PB89B | 4 | BDQ87 | C |
| VCCIO | VCCIO4 | 4 | | |
| AJ26 | PB90A | 4 | BDQ87 | T |
| AK26 | PB90B | 4 | BDQ87 | C |
| AF25 | PB91A | 4 | BDQ87 | T |
| AG25 | PB91B | 4 | BDQ87 | C |
| GND | GNDIO4 | - | | |
| AK22 | PB92A | 4 | BDQ96 | T |
| AJ22 | PB92B | 4 | BDQ96 | C |
| AE22 | PB93A | 4 | BDQ96 | T |
| AF22 | PB93B | 4 | BDQ96 | C |
| AG22 | PB94A | 4 | BDQ96 | T |
| VCCIO | VCCIO4 | 4 | | |
| AH22 | PB94B | 4 | BDQ96 | C |
| AG24 | PB95A | 4 | BDQ96 | T |
| AG23 | PB95B | 4 | BDQ96 | C |
| AE23 | PB96A | 4 | BDQS96 | |
| GND | GNDIO4 | - | | |
| AC22 | PB97A | 4 | BDQ96 | |
| AJ23 | PB98A | 4 | BDQ96 | T |
| VCCIO | VCCIO4 | 4 | | |
| AK23 | PB98B | 4 | BDQ96 | C |
| AD24 | PB99A | 4 | BDQ96 | T |
| AF24 | PB99B | 4 | BDQ96 | C |
| AC23 | PB100A | 4 | VREF2_4/BDQ96 | T |
| GND | GNDIO4 | - | | |
| AE24 | PB100B | 4 | VREF1_4/BDQ96 | C |
| AE25 | CFG2 | 8 | | |
| AB22 | CFG1 | 8 | | |
| AE26 | CFG0 | 8 | | |
| AA22 | PROGRAMN | 8 | | |
| AD25 | CCLK | 8 | | |
| AD26 | INITN | 8 | | |
| AC24 | DONE | 8 | | |
| GND | GNDIO4 | - | | |
| AC25 | PR90B | 8 | WRITEN | C |
| AE27 | PR90A | 8 | CS1N | T |
| AC26 | PR89B | 8 | CSN | C |
| AE28 | PR89A | 8 | D0/SPIFASTN | T |
| VCCIO | VCCIO8 | 8 | | |
| AD27 | PR88B | 8 | D1 | C |
| AD28 | PR88A | 8 | D2 | T |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|--------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AB24 | PR87B | 8 | D3 | C |
| GND | GNDIO4 | - | | |
| AB23 | PR87A | 8 | D4 | T |
| AB25 | PR86B | 8 | D5 | C |
| AB26 | PR86A | 8 | D6 | T |
| AC27 | PR85B | 8 | D7/SPID0 | C |
| VCCIO | VCCIO8 | 8 | | |
| AB27 | PR85A | 8 | DI/CSSPION | T |
| AD29 | PR84B | 8 | DOUT/CSON | C |
| AD30 | PR84A | 8 | BUSY/SISPI | T |
| AA25 | PR83B | 3 | RDQ80 | C |
| GND | GNDIO3 | - | | |
| AA23 | PR83A | 3 | RDQ80 | T |
| AC29 | PR82B | 3 | RDQ80 | C (LVDS)* |
| AC30 | PR82A | 3 | RDQ80 | T (LVDS)* |
| AA26 | PR81B | 3 | RDQ80 | C |
| VCCIO | VCCIO3 | 3 | | |
| AA24 | PR81A | 3 | RDQ80 | T |
| AB29 | PR80B | 3 | RDQ80 | C (LVDS)* |
| AB30 | PR80A | 3 | RDQS80 | T (LVDS)* |
| GND | GNDIO3 | - | | |
| Y23 | PR79B | 3 | RDQ80 | C |
| Y25 | PR79A | 3 | RDQ80 | T |
| AA27 | PR78B | 3 | RDQ80 | C (LVDS)* |
| AA28 | PR78A | 3 | RDQ80 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | |
| Y24 | PR77B | 3 | RLM0_GPLL_C_FB_A/RDQ80 | C |
| Y26 | PR77A | 3 | RLM0_GPLLT_FB_A/RDQ80 | T |
| AA29 | PR76B | 3 | RLM0_GPLL_C_IN_A**/RDQ80 | C (LVDS)* |
| AA30 | PR76A | 3 | RLM0_GPLLT_IN_A**/RDQ80 | T (LVDS)* |
| R22 | RLM0_PLLCAP | 3 | | |
| W23 | PR74B | 3 | RLM0_GDLL_C_FB_A/RDQ71 | C |
| W25 | PR74A | 3 | RLM0_GDLLT_FB_A/RDQ71 | T |
| GND | GNDIO3 | - | | |
| Y27 | PR73B | 3 | RLM0_GDLL_C_IN_A**/RDQ71 | C (LVDS)* |
| Y28 | PR73A | 3 | RLM0_GDLLT_IN_A**/RDQ71 | T (LVDS)* |
| W24 | PR72B | 3 | RDQ71 | C |
| W26 | PR72A | 3 | RDQ71 | T |
| VCCIO | VCCIO3 | 3 | | |
| Y29 | PR71B | 3 | RDQ71 | C (LVDS)* |
| Y30 | PR71A | 3 | RDQS71 | T (LVDS)* |
| V25 | PR70B | 3 | RDQ71 | C |
| GND | GNDIO3 | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| V23 | PR70A | 3 | RDQ71 | T |
| W27 | PR69B | 3 | RDQ71 | C (LVDS)* |
| W28 | PR69A | 3 | RDQ71 | T (LVDS)* |
| V26 | PR68B | 3 | RDQ71 | C |
| VCCIO | VCCIO3 | 3 | | |
| V24 | PR68A | 3 | RDQ71 | T |
| W29 | PR67B | 3 | RDQ71 | C (LVDS)* |
| W30 | PR67A | 3 | RDQ71 | T (LVDS)* |
| U25 | PR66B | 3 | RDQ63 | C |
| GND | GNDIO3 | - | | |
| U23 | PR66A | 3 | RDQ63 | T |
| V29 | PR65B | 3 | RDQ63 | C (LVDS)* |
| V30 | PR65A | 3 | RDQ63 | T (LVDS)* |
| U26 | PR64B | 3 | RDQ63 | C |
| VCCIO | VCCIO3 | 3 | | |
| U24 | PR64A | 3 | RDQ63 | T |
| U27 | PR63B | 3 | RDQ63 | C (LVDS)* |
| U28 | PR63A | 3 | RDQS63 | T (LVDS)* |
| GND | GNDIO3 | - | | |
| T23 | PR62B | 3 | RDQ63 | C |
| T25 | PR62A | 3 | RDQ63 | T |
| U29 | PR61B | 3 | RDQ63 | C (LVDS)* |
| U30 | PR61A | 3 | RDQ63 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | |
| T24 | PR60B | 3 | VREF2_3/RDQ63 | C |
| T26 | PR60A | 3 | VREF1_3/RDQ63 | T |
| T27 | PR59B | 3 | PCLKC3_0/RDQ63 | C (LVDS)* |
| T28 | PR59A | 3 | PCLKT3_0/RDQ63 | T (LVDS)* |
| R24 | PR57B | 2 | PCLKC2_0/RDQ54 | C |
| R26 | PR57A | 2 | PCLKT2_0/RDQ54 | T |
| GND | GNDIO2 | - | | |
| T29 | PR56B | 2 | RDQ54 | C (LVDS)* |
| T30 | PR56A | 2 | RDQ54 | T (LVDS)* |
| R23 | PR55B | 2 | RDQ54 | C |
| R25 | PR55A | 2 | RDQ54 | T |
| VCCIO | VCCIO2 | 2 | | |
| R27 | PR54B | 2 | RDQ54 | C (LVDS)* |
| R28 | PR54A | 2 | RDQS54 | T (LVDS)* |
| P26 | PR53B | 2 | RDQ54 | C |
| GND | GNDIO2 | - | | |
| P24 | PR53A | 2 | RDQ54 | T |
| R29 | PR52B | 2 | RDQ54 | C (LVDS)* |
| R30 | PR52A | 2 | RDQ54 | T (LVDS)* |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| P25 | PR51B | 2 | RDQ54 | C |
| VCCIO | VCCIO2 | 2 | | |
| P23 | PR51A | 2 | RDQ54 | T |
| P27 | PR50B | 2 | RDQ54 | C (LVDS)* |
| P28 | PR50A | 2 | RDQ54 | T (LVDS)* |
| GND | GNDIO2 | - | | |
| VCCIO | VCCIO2 | 2 | | |
| N24 | PR39B | 2 | RUM0_SPLLC_FB_A/RDQ37 | C |
| N26 | PR39A | 2 | RUM0_SPLLT_FB_A/RDQ37 | T |
| N23 | PR38B | 2 | RUM0_SPLLC_IN_A/RDQ37 | C |
| N25 | PR38A | 2 | RUM0_SPLLT_IN_A/RDQ37 | T |
| VCCIO | VCCIO2 | 2 | | |
| P29 | PR37B | 2 | RDQ37 | C (LVDS)* |
| P30 | PR37A | 2 | RDQS37 | T (LVDS)* |
| M26 | PR36B | 2 | RDQ37 | C |
| GND | GNDIO2 | - | | |
| M24 | PR36A | 2 | RDQ37 | T |
| N29 | PR35B | 2 | RDQ37 | C (LVDS)* |
| N30 | PR35A | 2 | RDQ37 | T (LVDS)* |
| M25 | PR34B | 2 | RDQ37 | C |
| VCCIO | VCCIO2 | 2 | | |
| M23 | PR34A | 2 | RDQ37 | T |
| M27 | PR33B | 2 | RDQ37 | C (LVDS)* |
| M28 | PR33A | 2 | RDQ37 | T (LVDS)* |
| L26 | PR32B | 2 | RDQ29 | C |
| GND | GNDIO2 | - | | |
| L24 | PR32A | 2 | RDQ29 | T |
| M29 | PR31B | 2 | RDQ29 | C (LVDS)* |
| M30 | PR31A | 2 | RDQ29 | T (LVDS)* |
| L25 | PR30B | 2 | RDQ29 | C |
| VCCIO | VCCIO2 | 2 | | |
| L23 | PR30A | 2 | RDQ29 | T |
| L27 | PR29B | 2 | RDQ29 | C (LVDS)* |
| L28 | PR29A | 2 | RDQS29 | T (LVDS)* |
| GND | GNDIO2 | - | | |
| K24 | PR28B | 2 | RDQ29 | C |
| K26 | PR28A | 2 | RDQ29 | T |
| L29 | PR27B | 2 | RDQ29 | C (LVDS)* |
| L30 | PR27A | 2 | RDQ29 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | |
| K23 | PR26B | 2 | RDQ29 | C |
| K25 | PR26A | 2 | RDQ29 | T |
| K27 | PR25B | 2 | RDQ29 | C (LVDS)* |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| K28 | PR25A | 2 | RDQ29 | T (LVDS)* |
| J24 | PR24B | 2 | RDQ21 | C |
| J26 | PR24A | 2 | RDQ21 | T |
| GND | GNDIO2 | - | | |
| K29 | PR23B | 2 | RDQ21 | C (LVDS)* |
| K30 | PR23A | 2 | RDQ21 | T (LVDS)* |
| J23 | PR22B | 2 | RDQ21 | C |
| J25 | PR22A | 2 | RDQ21 | T |
| VCCIO | VCCIO2 | 99 | | |
| J27 | PR21B | 2 | RDQ21 | C (LVDS)* |
| J28 | PR21A | 2 | RDQS21 | T (LVDS)* |
| H26 | PR20B | 2 | RDQ21 | C |
| GND | GNDIO2 | - | | |
| H24 | PR20A | 2 | RDQ21 | T |
| J29 | PR19B | 2 | RDQ21 | C (LVDS)* |
| J30 | PR19A | 2 | RDQ21 | T (LVDS)* |
| H25 | PR18B | 2 | RDQ21 | C |
| VCCIO | VCCIO2 | 2 | | |
| H23 | PR18A | 2 | RDQ21 | T |
| G27 | PR15B | 2 | RUM1_SPLLC_FB_A/RDQ12 | C |
| GND | GNDIO2 | - | | |
| H27 | PR15A | 2 | RUM1_SPLLT_FB_A/RDQ12 | T |
| G29 | PR14B | 2 | RUM1_SPLLC_IN_A/RDQ12 | C (LVDS)* |
| G28 | PR14A | 2 | RUM1_SPLLT_IN_A/RDQ12 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | |
| GND | GNDIO2 | - | | |
| G26 | PR6B | 2 | | C (LVDS)* |
| G25 | PR6A | 2 | | T (LVDS)* |
| G30 | PR5B | 2 | | C |
| F30 | PR5A | 2 | | T |
| VCCIO | VCCIO2 | 2 | | |
| F26 | PR4B | 2 | | C (LVDS)* |
| F27 | PR4A | 2 | | T (LVDS)* |
| F29 | PR3B | 2 | | C |
| GND | GNDIO2 | - | | |
| F28 | PR3A | 2 | | T |
| H29 | PR2B | 2 | VREF2_2 | C (LVDS)* |
| H30 | PR2A | 2 | VREF1_2 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | |
| B26 | PT100B | 1 | VREF2_1 | C |
| A26 | PT100A | 1 | VREF1_1 | T |
| GND | GNDIO1 | - | | |
| C25 | PT99B | 1 | | C |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| D25 | PT99A | 1 | | T |
| J22 | PT98B | 1 | | C |
| J21 | PT98A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| B25 | PT97B | 1 | | C |
| A25 | PT97A | 1 | | T |
| E24 | PT96B | 1 | | C |
| F24 | PT96A | 1 | | T |
| GND | GNDIO1 | - | | |
| F23 | PT95B | 1 | | C |
| H22 | PT95A | 1 | | T |
| D24 | PT94B | 1 | | C |
| C24 | PT94A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| E23 | PT93B | 1 | | C |
| G23 | PT93A | 1 | | T |
| B24 | PT92B | 1 | | C |
| A24 | PT92A | 1 | | T |
| C27 | PT91B | 1 | | C |
| GND | GNDIO1 | - | | |
| D27 | PT91A | 1 | | T |
| C26 | PT90B | 1 | | C |
| D26 | PT90A | 1 | | T |
| A27 | PT89B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | |
| B27 | PT89A | 1 | | T |
| A28 | PT88B | 1 | | C |
| B28 | PT88A | 1 | | T |
| A29 | PT87B | 1 | | C |
| B29 | PT87A | 1 | | T |
| GND | GNDIO1 | - | | |
| VCCIO | VCCIO1 | 1 | | |
| H21 | PT80B | 1 | | C |
| F22 | PT80A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| B23 | PT79B | 1 | | C |
| A23 | PT79A | 1 | | T |
| G24 | PT78B | 1 | | C |
| E22 | PT78A | 1 | | T |
| GND | GNDIO1 | - | | |
| D22 | PT77B | 1 | | C |
| C22 | PT77A | 1 | | T |
| G22 | PT76B | 1 | | C |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| E21 | PT76A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| B22 | PT75B | 1 | | C |
| A22 | PT75A | 1 | | T |
| H20 | PT74B | 1 | | C |
| F21 | PT74A | 1 | | T |
| F20 | PT73B | 1 | | C |
| GND | GNDIO1 | - | | |
| H19 | PT73A | 1 | | T |
| D21 | PT72B | 1 | | C |
| C21 | PT72A | 1 | | T |
| E20 | PT71B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | |
| G21 | PT71A | 1 | | T |
| B21 | PT70B | 1 | | C |
| A21 | PT70A | 1 | | T |
| F19 | PT69B | 1 | | C |
| G20 | PT69A | 1 | | T |
| E19 | PT68B | 1 | | C |
| GND | GNDIO1 | - | | |
| G19 | PT68A | 1 | | T |
| D20 | PT67B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | |
| C20 | PT67A | 1 | | T |
| B20 | PT66B | 1 | | C |
| A20 | PT66A | 1 | | T |
| F18 | PT65B | 1 | | C |
| H18 | PT65A | 1 | | T |
| D19 | PT64B | 1 | | C |
| C19 | PT64A | 1 | | T |
| GND | GNDIO1 | - | | |
| G18 | PT63B | 1 | | C |
| E18 | PT63A | 1 | | T |
| H17 | PT62B | 1 | | C |
| F17 | PT62A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| G17 | PT61B | 1 | | C |
| E17 | PT61A | 1 | | T |
| B19 | PT60B | 1 | | C |
| A19 | PT60A | 1 | | T |
| GND | GNDIO1 | - | | |
| D17 | PT59B | 1 | | C |
| B18 | PT59A | 1 | | T |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| C17 | PT58B | 1 | | C |
| A18 | PT58A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| H16 | PT57B | 1 | PCLKC1_0 | C |
| F16 | PT57A | 1 | PCLKT1_0 | T |
| K16 | XRES | 1 | | |
| E16 | PT55B | 0 | PCLKC0_0 | C |
| GND | GNDIO0 | - | | |
| G16 | PT55A | 0 | PCLKT0_0 | T |
| B17 | PT54B | 0 | | C |
| A17 | PT54A | 0 | | T |
| J15 | PT53B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| J16 | PT53A | 0 | | T |
| C16 | PT52B | 0 | | C |
| D16 | PT52A | 0 | | T |
| F15 | PT51B | 0 | | C |
| H15 | PT51A | 0 | | T |
| E15 | PT50B | 0 | | C |
| GND | GNDIO0 | - | | |
| G15 | PT50A | 0 | | T |
| C15 | PT49B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| D15 | PT49A | 0 | | T |
| B16 | PT48B | 0 | | C |
| A16 | PT48A | 0 | | T |
| E14 | PT47B | 0 | | C |
| G14 | PT47A | 0 | | T |
| B15 | PT46B | 0 | | C |
| A15 | PT46A | 0 | | T |
| GND | GNDIO0 | - | | |
| H14 | PT45B | 0 | | C |
| F14 | PT45A | 0 | | T |
| D14 | PT44B | 0 | | C |
| C14 | PT44A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | |
| G13 | PT43B | 0 | | C |
| E13 | PT43A | 0 | | T |
| B14 | PT42B | 0 | | C |
| A14 | PT42A | 0 | | T |
| GND | GNDIO0 | - | | |
| H13 | PT41B | 0 | | C |
| F13 | PT41A | 0 | | T |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| G12 | PT40B | 0 | | C |
| E12 | PT40A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | |
| B13 | PT39B | 0 | | C |
| A13 | PT39A | 0 | | T |
| H12 | PT38B | 0 | | C |
| F12 | PT38A | 0 | | T |
| C12 | PT37B | 0 | | C |
| GND | GNDIO0 | - | | |
| D12 | PT37A | 0 | | T |
| B12 | PT36B | 0 | | C |
| A12 | PT36A | 0 | | T |
| E11 | PT35B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| G11 | PT35A | 0 | | T |
| F11 | PT34B | 0 | | C |
| H11 | PT34A | 0 | | T |
| C11 | PT33B | 0 | | C |
| D11 | PT33A | 0 | | T |
| B11 | PT32B | 0 | | C |
| GND | GNDIO0 | - | | |
| A11 | PT32A | 0 | | T |
| E10 | PT31B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| G10 | PT31A | 0 | | T |
| F10 | PT30B | 0 | | C |
| H10 | PT30A | 0 | | T |
| D10 | PT29B | 0 | | C |
| C10 | PT29A | 0 | | T |
| GND | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | |
| A7 | PT16B | 0 | | C |
| B7 | PT16A | 0 | | T |
| A6 | PT15B | 0 | | C |
| B6 | PT15A | 0 | | T |
| C7 | PT14B | 0 | | C |
| GND | GNDIO0 | - | | |
| D7 | PT14A | 0 | | T |
| D8 | PT13B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| E7 | PT13A | 0 | | T |
| C6 | PT12B | 0 | | C |
| D6 | PT12A | 0 | | T |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| C5 | PT11B | 0 | | C |
| D5 | PT11A | 0 | | T |
| E9 | PT10B | 0 | | C |
| G9 | PT10A | 0 | | T |
| GND | GNDIO0 | - | | |
| B10 | PT9B | 0 | | C |
| A10 | PT9A | 0 | | T |
| D9 | PT8B | 0 | | C |
| C9 | PT8A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | |
| F9 | PT7B | 0 | | C |
| H9 | PT7A | 0 | | T |
| B9 | PT6B | 0 | | C |
| A9 | PT6A | 0 | | T |
| GND | GNDIO0 | - | | |
| E8 | PT5B | 0 | | C |
| G8 | PT5A | 0 | | T |
| A8 | PT4B | 0 | | C |
| B8 | PT4A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | |
| F8 | PT3B | 0 | | C |
| F7 | PT3A | 0 | | T |
| J10 | PT2B | 0 | VREF2_0 | C |
| J9 | PT2A | 0 | VREF1_0 | T |
| AA11 | VCC | - | | |
| AA20 | VCC | - | | |
| K11 | VCC | - | | |
| K21 | VCC | - | | |
| K22 | VCC | - | | |
| L11 | VCC | - | | |
| L12 | VCC | - | | |
| L13 | VCC | - | | |
| L18 | VCC | - | | |
| L19 | VCC | - | | |
| L20 | VCC | - | | |
| M11 | VCC | - | | |
| M20 | VCC | - | | |
| N11 | VCC | - | | |
| N20 | VCC | - | | |
| V11 | VCC | - | | |
| V20 | VCC | - | | |
| W11 | VCC | - | | |
| W20 | VCC | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| Y10 | VCC | - | | |
| Y11 | VCC | - | | |
| Y12 | VCC | - | | |
| Y13 | VCC | - | | |
| Y18 | VCC | - | | |
| Y19 | VCC | - | | |
| Y20 | VCC | - | | |
| J13 | VCCIO0 | 0 | | |
| J14 | VCCIO0 | 0 | | |
| K12 | VCCIO0 | 0 | | |
| K13 | VCCIO0 | 0 | | |
| K14 | VCCIO0 | 0 | | |
| K15 | VCCIO0 | 0 | | |
| J17 | VCCIO1 | 1 | | |
| J18 | VCCIO1 | 1 | | |
| J20 | VCCIO1 | 1 | | |
| K17 | VCCIO1 | 1 | | |
| K18 | VCCIO1 | 1 | | |
| K20 | VCCIO1 | 1 | | |
| L21 | VCCIO2 | 2 | | |
| M21 | VCCIO2 | 2 | | |
| M22 | VCCIO2 | 2 | | |
| N21 | VCCIO2 | 2 | | |
| N22 | VCCIO2 | 2 | | |
| R21 | VCCIO2 | 2 | | |
| U21 | VCCIO3 | 3 | | |
| U22 | VCCIO3 | 3 | | |
| V21 | VCCIO3 | 3 | | |
| V22 | VCCIO3 | 3 | | |
| W21 | VCCIO3 | 3 | | |
| Y22 | VCCIO3 | 3 | | |
| AA16 | VCCIO4 | 4 | | |
| AA17 | VCCIO4 | 4 | | |
| AA18 | VCCIO4 | 4 | | |
| AA19 | VCCIO4 | 4 | | |
| AB17 | VCCIO4 | 4 | | |
| AB18 | VCCIO4 | 4 | | |
| AA12 | VCCIO5 | 5 | | |
| AA13 | VCCIO5 | 5 | | |
| AA14 | VCCIO5 | 5 | | |
| AB12 | VCCIO5 | 5 | | |
| AB13 | VCCIO5 | 5 | | |
| AB14 | VCCIO5 | 5 | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| U10 | VCCIO6 | 6 | | |
| U9 | VCCIO6 | 6 | | |
| V10 | VCCIO6 | 6 | | |
| W10 | VCCIO6 | 6 | | |
| W9 | VCCIO6 | 6 | | |
| Y9 | VCCIO6 | 6 | | |
| L10 | VCCIO7 | 7 | | |
| L9 | VCCIO7 | 7 | | |
| M10 | VCCIO7 | 7 | | |
| N10 | VCCIO7 | 7 | | |
| P10 | VCCIO7 | 7 | | |
| R10 | VCCIO7 | 7 | | |
| AA21 | VCCIO8 | 8 | | |
| Y21 | VCCIO8 | 8 | | |
| AA15 | VCCAUX | - | | |
| AB11 | VCCAUX | - | | |
| AB19 | VCCAUX | - | | |
| AB20 | VCCAUX | - | | |
| J11 | VCCAUX | - | | |
| J12 | VCCAUX | - | | |
| J19 | VCCAUX | - | | |
| K19 | VCCAUX | - | | |
| L22 | VCCAUX | - | | |
| M9 | VCCAUX | - | | |
| N9 | VCCAUX | - | | |
| P21 | VCCAUX | - | | |
| P9 | VCCAUX | - | | |
| T10 | VCCAUX | - | | |
| T21 | VCCAUX | - | | |
| V9 | VCCAUX | - | | |
| W22 | VCCAUX | - | | |
| A1 | GND | - | | |
| A30 | GND | - | | |
| AC28 | GND | - | | |
| AC3 | GND | - | | |
| AH13 | GND | - | | |
| AH18 | GND | - | | |
| AH23 | GND | - | | |
| AH28 | GND | - | | |
| AH3 | GND | - | | |
| AH8 | GND | - | | |
| AK1 | GND | - | | |
| AK30 | GND | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| C13 | GND | - | | |
| C18 | GND | - | | |
| C23 | GND | - | | |
| C28 | GND | - | | |
| C3 | GND | - | | |
| C8 | GND | - | | |
| H28 | GND | - | | |
| H3 | GND | - | | |
| L14 | GND | - | | |
| L15 | GND | - | | |
| L16 | GND | - | | |
| L17 | GND | - | | |
| M12 | GND | - | | |
| M13 | GND | - | | |
| M14 | GND | - | | |
| M15 | GND | - | | |
| M16 | GND | - | | |
| M17 | GND | - | | |
| M18 | GND | - | | |
| M19 | GND | - | | |
| N12 | GND | - | | |
| N13 | GND | - | | |
| N14 | GND | - | | |
| N15 | GND | - | | |
| N16 | GND | - | | |
| N17 | GND | - | | |
| N18 | GND | - | | |
| N19 | GND | - | | |
| N28 | GND | - | | |
| N3 | GND | - | | |
| P11 | GND | - | | |
| P12 | GND | - | | |
| P13 | GND | - | | |
| P14 | GND | - | | |
| P15 | GND | - | | |
| P16 | GND | - | | |
| P17 | GND | - | | |
| P18 | GND | - | | |
| P19 | GND | - | | |
| P20 | GND | - | | |
| R11 | GND | - | | |
| R12 | GND | - | | |
| R13 | GND | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| R14 | GND | - | | |
| R15 | GND | - | | |
| R16 | GND | - | | |
| R17 | GND | - | | |
| R18 | GND | - | | |
| R19 | GND | - | | |
| R20 | GND | - | | |
| T11 | GND | - | | |
| T12 | GND | - | | |
| T13 | GND | - | | |
| T14 | GND | - | | |
| T15 | GND | - | | |
| T16 | GND | - | | |
| T17 | GND | - | | |
| T18 | GND | - | | |
| T19 | GND | - | | |
| T20 | GND | - | | |
| U11 | GND | - | | |
| U12 | GND | - | | |
| U13 | GND | - | | |
| U14 | GND | - | | |
| U15 | GND | - | | |
| U16 | GND | - | | |
| U17 | GND | - | | |
| U18 | GND | - | | |
| U19 | GND | - | | |
| U20 | GND | - | | |
| V12 | GND | - | | |
| V13 | GND | - | | |
| V14 | GND | - | | |
| V15 | GND | - | | |
| V16 | GND | - | | |
| V17 | GND | - | | |
| V18 | GND | - | | |
| V19 | GND | - | | |
| V28 | GND | - | | |
| V3 | GND | - | | |
| W12 | GND | - | | |
| W13 | GND | - | | |
| W14 | GND | - | | |
| W15 | GND | - | | |
| W16 | GND | - | | |
| W17 | GND | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| W18 | GND | - | | |
| W19 | GND | - | | |
| Y14 | GND | - | | |
| Y15 | GND | - | | |
| Y16 | GND | - | | |
| Y17 | GND | - | | |
| A2 | NC | - | | |
| A3 | NC | - | | |
| A4 | NC | - | | |
| A5 | NC | - | | |
| AB28 | NC | - | | |
| AC4 | NC | - | | |
| AD23 | NC | - | | |
| AE1 | NC | - | | |
| AE2 | NC | - | | |
| AE29 | NC | - | | |
| AE3 | NC | - | | |
| AE30 | NC | - | | |
| AE4 | NC | - | | |
| AE5 | NC | - | | |
| AE6 | NC | - | | |
| AF1 | NC | - | | |
| AF2 | NC | - | | |
| AF23 | NC | - | | |
| AF26 | NC | - | | |
| AF27 | NC | - | | |
| AF28 | NC | - | | |
| AF29 | NC | - | | |
| AF3 | NC | - | | |
| AF30 | NC | - | | |
| AF4 | NC | - | | |
| AF5 | NC | - | | |
| AG1 | NC | - | | |
| AG13 | NC | - | | |
| AG16 | NC | - | | |
| AG18 | NC | - | | |
| AG2 | NC | - | | |
| AG26 | NC | - | | |
| AG27 | NC | - | | |
| AG28 | NC | - | | |
| AG29 | NC | - | | |
| AG3 | NC | - | | |
| AG30 | NC | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AG4 | NC | - | | |
| AG8 | NC | - | | |
| AH1 | NC | - | | |
| AH16 | NC | - | | |
| AH2 | NC | - | | |
| AH26 | NC | - | | |
| AH27 | NC | - | | |
| AH29 | NC | - | | |
| AH30 | NC | - | | |
| AH4 | NC | - | | |
| AJ1 | NC | - | | |
| AJ2 | NC | - | | |
| AJ27 | NC | - | | |
| AJ28 | NC | - | | |
| AJ29 | NC | - | | |
| AJ3 | NC | - | | |
| AJ30 | NC | - | | |
| AK2 | NC | - | | |
| AK27 | NC | - | | |
| AK28 | NC | - | | |
| AK29 | NC | - | | |
| AK3 | NC | - | | |
| B1 | NC | - | | |
| B2 | NC | - | | |
| B3 | NC | - | | |
| B30 | NC | - | | |
| B4 | NC | - | | |
| B5 | NC | - | | |
| C1 | NC | - | | |
| C2 | NC | - | | |
| C29 | NC | - | | |
| C30 | NC | - | | |
| C4 | NC | - | | |
| D13 | NC | - | | |
| D18 | NC | - | | |
| D23 | NC | - | | |
| D28 | NC | - | | |
| D29 | NC | - | | |
| D3 | NC | - | | |
| D30 | NC | - | | |
| D4 | NC | - | | |
| E25 | NC | - | | |
| E26 | NC | - | | |

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2-70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| E27 | NC | - | | |
| E28 | NC | - | | |
| E29 | NC | - | | |
| E3 | NC | - | | |
| E30 | NC | - | | |
| E4 | NC | - | | |
| E5 | NC | - | | |
| E6 | NC | - | | |
| F25 | NC | - | | |
| F5 | NC | - | | |
| F6 | NC | - | | |
| G6 | NC | - | | |
| G7 | NC | - | | |
| K10 | NC | - | | |
| K9 | NC | - | | |
| N27 | NC | - | | |
| N4 | NC | - | | |
| R1 | NC | - | | |
| R2 | NC | - | | |
| V27 | NC | - | | |
| V4 | NC | - | | |
| P22 | VCCPLL | - | | |
| P8 | VCCPLL | - | | |
| T22 | VCCPLL | - | | |
| Y7 | VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| A2 | PL2A | 7 | LDQ6 | T (LVDS)* | PL2A | 7 | LDQ6 | T (LVDS)* |
| B2 | PL2B | 7 | LDQ6 | C (LVDS)* | PL2B | 7 | LDQ6 | C(LVDS)* |
| D3 | PL3A | 7 | LDQ6 | T | PL3A | 7 | LDQ6 | T |
| C2 | PL3B | 7 | LDQ6 | C | PL3B | 7 | LDQ6 | C |
| E4 | PL4A | 7 | LDQ6 | T (LVDS)* | PL4A | 7 | LDQ6 | T (LVDS)* |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| E5 | PL4B | 7 | LDQ6 | C (LVDS)* | PL4B | 7 | LDQ6 | C(LVDS)* |
| B1 | PL5A | 7 | LDQ6 | T | PL5A | 7 | LDQ6 | T |
| C1 | PL5B | 7 | LDQ6 | C | PL5B | 7 | LDQ6 | C |
| D2 | PL6A | 7 | LDQS6 | T (LVDS)* | PL6A | 7 | LDQS6 | T (LVDS)* |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| D1 | PL6B | 7 | LDQ6 | C (LVDS)* | PL6B | 7 | LDQ6 | C(LVDS)* |
| E1 | PL7A | 7 | LDQ6 | T | PL7A | 7 | LDQ6 | T |
| F1 | PL7B | 7 | LDQ6 | C | PL7B | 7 | LDQ6 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| F3 | PL8A | 7 | LDQ6 | T (LVDS)* | PL8A | 7 | LDQ6 | T (LVDS)* |
| F2 | PL8B | 7 | LDQ6 | C (LVDS)* | PL8B | 7 | LDQ6 | C(LVDS)* |
| F6 | PL9A | 7 | VREF2_7/LDQ6 | T | PL9A | 7 | VREF2_7/LDQ6 | T |
| F5 | PL9B | 7 | VREF1_7/LDQ6 | C | PL9B | 7 | VREF1_7/LDQ6 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| G4 | PL11A | 7 | LUM0_SPLLT_IN_A | T (LVDS)* | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* |
| G3 | PL11B | 7 | LUM0_SPLLC_IN_A | C (LVDS)* | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C(LVDS)* |
| G1 | PL12A | 7 | LUM0_SPLLT_FB_A | T | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T |
| G2 | PL12B | 7 | LUM0_SPLLC_FB_A | C | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C |
| H1 | PL13A | 7 | | T (LVDS)* | PL13A | 7 | LDQ15 | T (LVDS)* |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J1 | PL13B | 7 | | C (LVDS)* | PL13B | 7 | LDQ15 | C(LVDS)* |
| H2 | PL14A | 7 | | T | PL14A | 7 | LDQ15 | T |
| H3 | PL14B | 7 | | C | PL14B | 7 | LDQ15 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| G6 | PL24A | 7 | LDQ22 | T (LVDS)* | PL34A | 7 | LDQ32 | T (LVDS)* |
| H6 | PL24B | 7 | LDQ22 | C (LVDS)* | PL34B | 7 | LDQ32 | C(LVDS)* |
| J2 | PL25A | 7 | PCLKT7_0/LDQ22 | T | PL35A | 7 | PCLKT7_0/LDQ32 | T |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| K1 | PL25B | 7 | PCLKC7_0/LDQ22 | C | PL35B | 7 | PCLKC7_0/LDQ32 | C |
| H4 | PL27A | 6 | PCLKT6_0 | T (LVDS)* | PL37A | 6 | PCLKT6_0 | T (LVDS)* |
| H5 | PL27B | 6 | PCLKC6_0 | C (LVDS)* | PL37B | 6 | PCLKC6_0 | C(LVDS)* |
| J4 | PL28A | 6 | VREF2_6 | T | PL38A | 6 | VREF2_6 | T |
| K4 | PL28B | 6 | VREF1_6 | C | PL38B | 6 | VREF1_6 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| J6 | PL31A | 6 | LLM1_SPLLT_IN_A | T (LVDS)* | PL41A | 6 | LLM2_SPLLT_IN_A | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| J5 | PL31B | 6 | LLM1_SPLLC_IN_A | C (LVDS)* | PL41B | 6 | LLM2_SPLLC_IN_A | C(LVDS)* |
| K3 | PL32A | 6 | LLM1_SPLLT_FB_A | T | PL42A | 6 | LLM2_SPLLT_FB_A | T |
| K2 | PL32B | 6 | LLM1_SPLLC_FB_A | C | PL42B | 6 | LLM2_SPLLC_FB_A | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| L1 | PL42A | 6 | LLM0_GPLLT_IN_A | T (LVDS)* | PL57A | 6 | LLM0_GPLLT_IN_A**/LDQS57*** | T (LVDS)* |

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|------------------|--------------|-------------------|------|--------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| L2 | PL42B | 6 | LLM0_GPLL_C_IN_A | C (LVDS)* | PL57B | 6 | LLM0_GPLL_C_IN_A**/LDQ57 | C(LVDS)* | |
| L3 | PL43A | 6 | LLM0_GPLL_T_FB_A | T | PL58A | 6 | LLM0_GPLL_T_FB_A/LDQ57 | T | |
| L4 | PL43B | 6 | LLM0_GPLL_C_FB_A | C | PL58B | 6 | LLM0_GPLL_C_FB_A/LDQ57 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| M1 | PL44A | 6 | LLM0_GDLLT_IN_A | T (LVDS)* | PL59A | 6 | LLM0_GDLLT_IN_A**/LDQ57 | T (LVDS)* | |
| N1 | PL44B | 6 | LLM0_GDLLC_IN_A | C (LVDS)* | PL59B | 6 | LLM0_GDLLC_IN_A**/LDQ57 | C(LVDS)* | |
| N2 | PL45A | 6 | LLM0_GDLLT_FB_A | T | PL60A | 6 | LLM0_GDLLT_FB_A/LDQ57 | T | |
| N3 | PL45B | 6 | LLM0_GDLLC_FB_A | C | PL60B | 6 | LLM0_GDLLC_FB_A/LDQ57 | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| M4 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| K6 | TCK | - | | | TCK | - | | | |
| L5 | TDI | - | | | TDI | - | | | |
| N4 | TMS | - | | | TMS | - | | | |
| N6 | TDO | - | | | TDO | - | | | |
| K7 | VCCJ | - | | | VCCJ | - | | | |
| M5 | PB2A | 5 | BDQ6 | T | PB2A | 5 | BDQ6 | T | |
| N5 | PB2B | 5 | BDQ6 | C | PB2B | 5 | BDQ6 | C | |
| L6 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T | |
| M6 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C | |
| P3 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| P4 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C | |
| P2 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T | |
| P1 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C | |
| R1 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| R2 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C | |
| R3 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T | |
| T2 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C | |
| R4 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| T3 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C | |
| T4 | PB10A | 5 | BDQ6 | T | PB10A | 5 | BDQ6 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| T5 | PB10B | 5 | BDQ6 | C | PB10B | 5 | BDQ6 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| T6 | PB16A | 5 | VREF2_5/BDQ15 | T | PB34A | 5 | VREF2_5/BDQ33 | T | |
| R6 | PB16B | 5 | VREF1_5/BDQ15 | C | PB34B | 5 | VREF1_5/BDQ33 | C | |
| P6 | PB17A | 5 | PCLKT5_0/BDQ15 | T | PB35A | 5 | PCLKT5_0/BDQ33 | T | |
| P7 | PB17B | 5 | PCLKC5_0/BDQ15 | C | PB35B | 5 | PCLKC5_0/BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| T7 | PB22A | 4 | PCLKT4_0/BDQ24 | T | PB40A | 4 | PCLKT4_0/BDQ42 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| T8 | PB22B | 4 | PCLKC4_0/BDQ24 | C | PB40B | 4 | PCLKC4_0/BDQ42 | C | |

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| L7 | PB23A | 4 | VREF2_4/BDQ24 | T | PB41A | 4 | VREF2_4/BDQ42 | T | |
| L8 | PB23B | 4 | VREF1_4/BDQ24 | C | PB41B | 4 | VREF1_4/BDQ42 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| P8 | PB29A | 4 | BDQ33 | T | PB47A | 4 | BDQ51 | T | |
| N8 | PB29B | 4 | BDQ33 | C | PB47B | 4 | BDQ51 | C | |
| R7 | PB30A | 4 | BDQ33 | T | PB48A | 4 | BDQ51 | T | |
| R8 | PB30B | 4 | BDQ33 | C | PB48B | 4 | BDQ51 | C | |
| N7 | PB31A | 4 | BDQ33 | T | PB49A | 4 | BDQ51 | T | |
| M8 | PB31B | 4 | BDQ33 | C | PB49B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| R9 | PB32A | 4 | BDQ33 | T | PB50A | 4 | BDQ51 | T | |
| T9 | PB32B | 4 | BDQ33 | C | PB50B | 4 | BDQ51 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| T10 | PB33A | 4 | BDQS33 | T | PB51A | 4 | BDQS51 | T | |
| R10 | PB33B | 4 | BDQ33 | C | PB51B | 4 | BDQ51 | C | |
| N9 | PB34A | 4 | BDQ33 | T | PB52A | 4 | BDQ51 | T | |
| P10 | PB34B | 4 | BDQ33 | C | PB52B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| L9 | PB47A | 4 | BDQ51 | T | PB65A | 4 | BDQ69 | T | |
| M9 | PB47B | 4 | BDQ51 | C | PB65B | 4 | BDQ69 | C | |
| T11 | PB49A | 4 | BDQ51 | T | PB67A | 4 | BDQ69 | T | |
| R11 | PB49B | 4 | BDQ51 | C | PB67B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| T12 | PB50A | 4 | BDQ51 | T | PB68A | 4 | BDQ69 | T | |
| T13 | PB50B | 4 | BDQ51 | C | PB68B | 4 | BDQ69 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| P11 | PB51A | 4 | BDQS51 | T | PB69A | 4 | BDQS69 | T | |
| N10 | PB51B | 4 | BDQ51 | C | PB69B | 4 | BDQ69 | C | |
| T14 | PB52A | 4 | BDQ51 | T | PB70A | 4 | BDQ69 | T | |
| R13 | PB52B | 4 | BDQ51 | C | PB70B | 4 | BDQ69 | C | |
| R15 | PB53A | 4 | BDQ51 | T | PB71A | 4 | BDQ69 | T | |
| R16 | PB53B | 4 | BDQ51 | C | PB71B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| R14 | PB54A | 4 | BDQ51 | T | PB72A | 4 | BDQ69 | T | |
| P15 | PB54B | 4 | BDQ51 | C | PB72B | 4 | BDQ69 | C | |
| P16 | PB55A | 4 | BDQ51 | T | PB73A | 4 | BDQ69 | T | |
| P14 | PB55B | 4 | BDQ51 | C | PB73B | 4 | BDQ69 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| L11 | CFG2 | 8 | | | CFG2 | 8 | | | |
| L10 | CFG1 | 8 | | | CFG1 | 8 | | | |
| P13 | CFG0 | 8 | | | CFG0 | 8 | | | |
| N12 | PROGRAMN | 8 | | | PROGRAMN | 8 | | | |
| N11 | CCLK | 8 | | | CCLK | 8 | | | |
| M11 | INITN | 8 | | | INITN | 8 | | | |
| N13 | DONE | 8 | | | DONE | 8 | | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | | |

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|------------------|--------------|-------------------|------|--------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| M12 | PR53B | 8 | WRITEN | C | PR68B | 8 | WRITEN | C | |
| M13 | PR53A | 8 | CS1N | T | PR68A | 8 | CS1N | T | |
| N14 | PR52B | 8 | CSN | C | PR67B | 8 | CSN | C | |
| N15 | PR52A | 8 | D0/SPIFASTN | T | PR67A | 8 | D0/SPIFASTN | T | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| N16 | PR51B | 8 | D1 | C | PR66B | 8 | D1 | C | |
| M16 | PR51A | 8 | D2 | T | PR66A | 8 | D2 | T | |
| L12 | PR50B | 8 | D3 | C | PR65B | 8 | D3 | C | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | | |
| L13 | PR50A | 8 | D4 | T | PR65A | 8 | D4 | T | |
| L16 | PR49B | 8 | D5 | C | PR64B | 8 | D5 | C | |
| K16 | PR49A | 8 | D6 | T | PR64A | 8 | D6 | T | |
| L14 | PR48B | 8 | D7/SPID0*** | C | PR63B | 8 | D7/SPID0*** | C | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| L15 | PR48A | 8 | DI/CSSPI0N | T | PR63A | 8 | DI/CSSPI0N | T | |
| K13 | PR47B | 8 | DOU/CSON/CSSPI1N | C | PR62B | 8 | DOU/CSON/CSSPI1N | C | |
| K14 | PR47A | 8 | BUSY/SISPI | T | PR62A | 8 | BUSY/SISPI | T | |
| K11 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | | |
| K15 | PR45B | 3 | RLM0_GDLLC_FB_A | C | PR60B | 3 | RLM0_GDLLC_FB_A/RDQ57 | C | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| J16 | PR45A | 3 | RLM0_GDLLT_FB_A | T | PR60A | 3 | RLM0_GDLLT_FB_A/RDQ57 | T | |
| H16 | PR44B | 3 | RLM0_GDLLC_IN_A | C (LVDS)* | PR59B | 3 | RLM0_GDLLC_IN_A**/RDQ57 | C (LVDS)* | |
| J15 | PR44A | 3 | RLM0_GDLLT_IN_A | T (LVDS)* | PR59A | 3 | RLM0_GDLLT_IN_A**/RDQ57 | T (LVDS)* | |
| J14 | PR43B | 3 | RLM0_GPLLC_IN_A | C | PR58B | 3 | RLM0_GPLLC_IN_A**/RDQ57 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| J13 | PR43A | 3 | RLM0_GPLLT_IN_A | T | PR58A | 3 | RLM0_GPLLT_IN_A**/RDQ57 | T | |
| H13 | PR42B | 3 | RLM0_GPLLC_FB_A | C (LVDS)* | PR57B | 3 | RLM0_GPLLC_FB_A/RDQ57 | C (LVDS)* | |
| H12 | PR42A | 3 | RLM0_GPLLT_FB_A | T (LVDS)* | PR57A | 3 | RLM0_GPLLT_FB_A/RDQ57*** | T (LVDS)* | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| G16 | PR32B | 3 | RLM1_SPLLC_FB_A | C | PR42B | 3 | RLM2_SPLLC_FB_A | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| H15 | PR32A | 3 | RLM1_SPLLT_FB_A | T | PR42A | 3 | RLM2_SPLLT_FB_A | T | |
| E16 | PR31B | 3 | RLM1_SPLLC_IN_A | C (LVDS)* | PR41B | 3 | RLM2_SPLLC_IN_A | C (LVDS)* | |
| F15 | PR31A | 3 | RLM1_SPLLT_IN_A | T (LVDS)* | PR41A | 3 | RLM2_SPLLT_IN_A | T (LVDS)* | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| F16 | PR28B | 3 | VREF2_3 | C | PR38B | 3 | VREF2_3 | C | |
| G15 | PR28A | 3 | VREF1_3 | T | PR38A | 3 | VREF1_3 | T | |
| J11 | PR27B | 3 | PCLKC3_0 | C (LVDS)* | PR37B | 3 | PCLKC3_0 | C (LVDS)* | |
| J12 | PR27A | 3 | PCLKT3_0 | T (LVDS)* | PR37A | 3 | PCLKT3_0 | T (LVDS)* | |
| G14 | PR25B | 2 | PCLKC2_0/RDQ22 | C | PR35B | 2 | PCLKC2_0/RDQ32 | C | |
| G13 | PR25A | 2 | PCLKT2_0/RDQ22 | T | PR35A | 2 | PCLKT2_0/RDQ32 | T | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| F14 | PR24B | 2 | RDQ22 | C (LVDS)* | PR34B | 2 | RDQ32 | C (LVDS)* | |
| F13 | PR24A | 2 | RDQ22 | T (LVDS)* | PR34A | 2 | RDQ32 | T (LVDS)* | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| H11 | PR14B | 2 | | C | PR14B | 2 | RDQ15 | C | |

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| G11 | PR14A | 2 | | T | PR14A | 2 | RDQ15 | T |
| E13 | PR13B | 2 | | C (LVDS)* | PR13B | 2 | RDQ15 | C(LVDS)* |
| F12 | PR13A | 2 | | T (LVDS)* | PR13A | 2 | RDQ15 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| F11 | PR12B | 2 | RUM0_SPLLC_FB_A | C | PR12B | 2 | RUM0_SPLLC_FB_A/RDQ15 | C |
| E12 | PR12A | 2 | RUM0_SPLLT_FB_A | T | PR12A | 2 | RUM0_SPLLT_FB_A/RDQ15 | T |
| D16 | PR11B | 2 | RUM0_SPLLC_IN_A | C (LVDS)* | PR11B | 2 | RUM0_SPLLC_IN_A/RDQ15 | C(LVDS)* |
| D15 | PR11A | 2 | RUM0_SPLLT_IN_A | T (LVDS)* | PR11A | 2 | RUM0_SPLLT_IN_A/RDQ15 | T (LVDS)* |
| C16 | PR9B | 2 | VREF2_2 | C | PR9B | 2 | VREF2_2 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| B16 | PR9A | 2 | VREF1_2 | T | PR9A | 2 | VREF1_2 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| F4 | XRES | - | | | XRES | - | | |
| C15 | URC_SQ_VCCR_X0 | 12 | | | URC_SQ_VCCR_X0 | 12 | | |
| A14 | URC_SQ_HDIN_P0 | 12 | | T | URC_SQ_HDIN_P0 | 12 | | T |
| B15 | URC_SQ_VCCIB0 | 12 | | | URC_SQ_VCCIB0 | 12 | | |
| B14 | URC_SQ_HDINN0 | 12 | | C | URC_SQ_HDINN0 | 12 | | C |
| C12 | URC_SQ_VCCTX0 | 12 | | | URC_SQ_VCCTX0 | 12 | | |
| A11 | URC_SQ_HDOUT_P0 | 12 | | T | URC_SQ_HDOUT_P0 | 12 | | T |
| A12 | URC_SQ_VCCOB0 | 12 | | | URC_SQ_VCCOB0 | 12 | | |
| B11 | URC_SQ_HDOUTN0 | 12 | | C | URC_SQ_HDOUTN0 | 12 | | C |
| C11 | URC_SQ_VCCTX1 | 12 | | | URC_SQ_VCCTX1 | 12 | | |
| B10 | URC_SQ_HDOUTN1 | 12 | | C | URC_SQ_HDOUTN1 | 12 | | C |
| C10 | URC_SQ_VCCOB1 | 12 | | | URC_SQ_VCCOB1 | 12 | | |
| A10 | URC_SQ_HDOUT_P1 | 12 | | T | URC_SQ_HDOUT_P1 | 12 | | T |
| C14 | URC_SQ_VCCR_X1 | 12 | | | URC_SQ_VCCR_X1 | 12 | | |
| B13 | URC_SQ_HDINN1 | 12 | | C | URC_SQ_HDINN1 | 12 | | C |
| C13 | URC_SQ_VCCIB1 | 12 | | | URC_SQ_VCCIB1 | 12 | | |
| A13 | URC_SQ_HDIN_P1 | 12 | | T | URC_SQ_HDIN_P1 | 12 | | T |
| B9 | URC_SQ_VCCAUX33 | 12 | | | URC_SQ_VCCAUX33 | 12 | | |
| D8 | URC_SQ_REFCLKN | 12 | | C | URC_SQ_REFCLKN | 12 | | C |
| D9 | URC_SQ_REFCLKP | 12 | | T | URC_SQ_REFCLKP | 12 | | T |
| C9 | URC_SQ_VCCP | 12 | | | URC_SQ_VCCP | 12 | | |
| A5 | URC_SQ_HDIN_P2 | 12 | | T | URC_SQ_HDIN_P2 | 12 | | T |
| C5 | URC_SQ_VCCIB2 | 12 | | | URC_SQ_VCCIB2 | 12 | | |
| B5 | URC_SQ_HDINN2 | 12 | | C | URC_SQ_HDINN2 | 12 | | C |
| C4 | URC_SQ_VCCR_X2 | 12 | | | URC_SQ_VCCR_X2 | 12 | | |
| A8 | URC_SQ_HDOUT_P2 | 12 | | T | URC_SQ_HDOUT_P2 | 12 | | T |
| C8 | URC_SQ_VCCOB2 | 12 | | | URC_SQ_VCCOB2 | 12 | | |
| B8 | URC_SQ_HDOUTN2 | 12 | | C | URC_SQ_HDOUTN2 | 12 | | C |
| C7 | URC_SQ_VCCTX2 | 12 | | | URC_SQ_VCCTX2 | 12 | | |
| B7 | URC_SQ_HDOUTN3 | 12 | | C | URC_SQ_HDOUTN3 | 12 | | C |
| A6 | URC_SQ_VCCOB3 | 12 | | | URC_SQ_VCCOB3 | 12 | | |
| A7 | URC_SQ_HDOUT_P3 | 12 | | T | URC_SQ_HDOUT_P3 | 12 | | T |
| C6 | URC_SQ_VCCTX3 | 12 | | | URC_SQ_VCCTX3 | 12 | | |
| B4 | URC_SQ_HDINN3 | 12 | | C | URC_SQ_HDINN3 | 12 | | C |
| B3 | URC_SQ_VCCIB3 | 12 | | | URC_SQ_VCCIB3 | 12 | | |
| A4 | URC_SQ_HDIN_P3 | 12 | | T | URC_SQ_HDIN_P3 | 12 | | T |
| C3 | URC_SQ_VCCR_X3 | 12 | | | URC_SQ_VCCR_X3 | 12 | | |

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | | |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| G10 | VCCPLL | - | | | VCCPLL | - | | | |
| G7 | VCC | - | | | VCC | - | | | |
| G9 | VCC | - | | | VCC | - | | | |
| H7 | VCC | - | | | VCC | - | | | |
| J10 | VCC | - | | | VCC | - | | | |
| K10 | VCC | - | | | VCC | - | | | |
| K8 | VCC | - | | | VCC | - | | | |
| E7 | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| E10 | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| E14 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| G12 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| K12 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| M14 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| M10 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| P12 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| M7 | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| P5 | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| K5 | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| M3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| E3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| G5 | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| T15 | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| G8 | VCCAUX | - | | | VCCAUX | - | | | |
| H10 | VCCAUX | - | | | VCCAUX | - | | | |
| J7 | VCCAUX | - | | | VCCAUX | - | | | |
| K9 | VCCAUX | - | | | VCCAUX | - | | | |
| A1 | GND | - | | | GND | - | | | |
| A15 | GND | - | | | GND | - | | | |
| A16 | GND | - | | | GND | - | | | |
| A3 | GND | - | | | GND | - | | | |
| A9 | GND | - | | | GND | - | | | |
| B12 | GND | - | | | GND | - | | | |
| B6 | GND | - | | | GND | - | | | |
| E15 | GND | - | | | GND | - | | | |
| E2 | GND | - | | | GND | - | | | |
| H14 | GND | - | | | GND | - | | | |

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| H8 | GND | - | | | GND | - | | | |
| H9 | GND | - | | | GND | - | | | |
| J3 | GND | - | | | GND | - | | | |
| J8 | GND | - | | | GND | - | | | |
| J9 | GND | - | | | GND | - | | | |
| M15 | GND | - | | | GND | - | | | |
| M2 | GND | - | | | GND | - | | | |
| P9 | GND | - | | | GND | - | | | |
| R12 | GND | - | | | GND | - | | | |
| R5 | GND | - | | | GND | - | | | |
| T1 | GND | - | | | GND | - | | | |
| T16 | GND | - | | | GND | - | | | |
| D10 | NC | - | | | NC | - | | | |
| D11 | NC | - | | | NC | - | | | |
| D12 | NC | - | | | NC | - | | | |
| D13 | NC | - | | | NC | - | | | |
| D14 | NC | - | | | NC | - | | | |
| D4 | NC | - | | | NC | - | | | |
| D5 | NC | - | | | NC | - | | | |
| D6 | NC | - | | | NC | - | | | |
| D7 | NC | - | | | NC | - | | | |
| E11 | NC | - | | | NC | - | | | |
| E6 | NC | - | | | NC | - | | | |
| E8 | NC | - | | | NC | - | | | |
| E9 | NC | - | | | NC | - | | | |
| F10 | NC | - | | | NC | - | | | |
| F7 | NC | - | | | NC | - | | | |
| F8 | NC | - | | | NC | - | | | |
| F9 | NC | - | | | NC | - | | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.
 ** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
 ***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| D1 | PL2A | 7 | LDQ6 | T (LVDS)* | PL2A | 7 | LDQ6 | T (LVDS)* | |
| E1 | PL2B | 7 | LDQ6 | C (LVDS)* | PL2B | 7 | LDQ6 | C (LVDS)* | |
| F1 | PL3A | 7 | LDQ6 | T | PL3A | 7 | LDQ6 | T | |
| F2 | PL3B | 7 | LDQ6 | C | PL3B | 7 | LDQ6 | C | |
| F5 | PL4A | 7 | LDQ6 | T (LVDS)* | PL4A | 7 | LDQ6 | T (LVDS)* | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| G6 | PL4B | 7 | LDQ6 | C (LVDS)* | PL4B | 7 | LDQ6 | C (LVDS)* | |
| F4 | PL5A | 7 | LDQ6 | T | PL5A | 7 | LDQ6 | T | |
| F3 | PL5B | 7 | LDQ6 | C | PL5B | 7 | LDQ6 | C | |
| G1 | PL6A | 7 | LDQS6 | T (LVDS)* | PL6A | 7 | LDQS6 | T (LVDS)* | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| G2 | PL6B | 7 | LDQ6 | C (LVDS)* | PL6B | 7 | LDQ6 | C (LVDS)* | |
| H1 | PL7A | 7 | LDQ6 | T | PL7A | 7 | LDQ6 | T | |
| H2 | PL7B | 7 | LDQ6 | C | PL7B | 7 | LDQ6 | C | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| H7 | PL8A | 7 | LDQ6 | T (LVDS)* | PL8A | 7 | LDQ6 | T (LVDS)* | |
| H6 | PL8B | 7 | LDQ6 | C (LVDS)* | PL8B | 7 | LDQ6 | C (LVDS)* | |
| G3 | PL9A | 7 | VREF2_7/LDQ6 | T | PL9A | 7 | VREF2_7/LDQ6 | T | |
| H3 | PL9B | 7 | VREF1_7/LDQ6 | C | PL9B | 7 | VREF1_7/LDQ6 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| H5 | PL11A | 7 | LUM0_SPLLT_IN_A | T (LVDS)* | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* | |
| H4 | PL11B | 7 | LUM0_SPLLC_IN_A | C (LVDS)* | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C (LVDS)* | |
| J1 | PL12A | 7 | LUM0_SPLLT_FB_A | T | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T | |
| J2 | PL12B | 7 | LUM0_SPLLC_FB_A | C | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C | |
| J3 | PL13A | 7 | | T (LVDS)* | PL13A | 7 | LDQ15 | T (LVDS)* | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| J4 | PL13B | 7 | | C (LVDS)* | PL13B | 7 | LDQ15 | C (LVDS)* | |
| J7 | PL14A | 7 | | T | PL14A | 7 | LDQ15 | T | |
| J6 | PL14B | 7 | | C | PL14B | 7 | LDQ15 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| K1 | PL18A | 7 | LUM1_SPLLT_IN_A/LDQ22 | T (LVDS)* | PL28A | 7 | LUM1_SPLLT_IN_A/LDQ32 | T (LVDS)* | |
| K2 | PL18B | 7 | LUM1_SPLLC_IN_A/LDQ22 | C (LVDS)* | PL28B | 7 | LUM1_SPLLC_IN_A/LDQ32 | C (LVDS)* | |
| J5 | PL19A | 7 | LUM1_SPLLT_FB_A/LDQ22 | T | PL29A | 7 | LUM1_SPLLT_FB_A/LDQ32 | T | |
| K5 | PL19B | 7 | LUM1_SPLLC_FB_A/LDQ22 | C | PL29B | 7 | LUM1_SPLLC_FB_A/LDQ32 | C | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| K7 | PL20A | 7 | LDQ22 | T (LVDS)* | PL30A | 7 | LDQ32 | T (LVDS)* | |
| K6 | PL20B | 7 | LDQ22 | C (LVDS)* | PL30B | 7 | LDQ32 | C (LVDS)* | |
| L6 | PL21A | 7 | LDQ22 | T | PL31A | 7 | LDQ32 | T | |
| L7 | PL21B | 7 | LDQ22 | C | PL31B | 7 | LDQ32 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| L1 | PL22A | 7 | LDQS22 | T (LVDS)* | PL32A | 7 | LDQS32 | T (LVDS)* | |
| L2 | PL22B | 7 | LDQ22 | C (LVDS)* | PL32B | 7 | LDQ32 | C (LVDS)* | |
| M7 | PL23A | 7 | LDQ22 | T | PL33A | 7 | LDQ32 | T | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| L5 | PL23B | 7 | LDQ22 | C | PL33B | 7 | LDQ32 | C | |
| L3 | PL24A | 7 | LDQ22 | T (LVDS)* | PL34A | 7 | LDQ32 | T (LVDS)* | |
| L4 | PL24B | 7 | LDQ22 | C (LVDS)* | PL34B | 7 | LDQ32 | C (LVDS)* | |
| M1 | PL25A | 7 | PCLKT7_0/LDQ22 | T | PL35A | 7 | PCLKT7_0/LDQ32 | T | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|-------------------|--------------|-------------------|------|------------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| M2 | PL25B | 7 | PCLKC7_0/LDQ22 | C | PL35B | 7 | PCLKC7_0/LDQ32 | C | |
| M6 | PL27A | 6 | PCLKT6_0 | T (LVDS)* | PL37A | 6 | PCLKT6_0 | T (LVDS)* | |
| M5 | PL27B | 6 | PCLKC6_0 | C (LVDS)* | PL37B | 6 | PCLKC6_0 | C (LVDS)* | |
| M3 | PL28A | 6 | VREF2_6 | T | PL38A | 6 | VREF2_6 | T | |
| M4 | PL28B | 6 | VREF1_6 | C | PL38B | 6 | VREF1_6 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| N7 | PL31A | 6 | LLM1_SPLLT_IN_A | T (LVDS)* | PL41A | 6 | LLM2_SPLLT_IN_A | T (LVDS)* | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| N6 | PL31B | 6 | LLM1_SPLLC_IN_A | C (LVDS)* | PL41B | 6 | LLM2_SPLLC_IN_A | C (LVDS)* | |
| N1 | PL32A | 6 | LLM1_SPLLT_FB_A | T | PL42A | 6 | LLM2_SPLLT_FB_A | T | |
| N2 | PL32B | 6 | LLM1_SPLLC_FB_A | C | PL42B | 6 | LLM2_SPLLC_FB_A | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| P6 | PL38A | 6 | LDQS38**** | T (LVDS)* | PL48A | 6 | LDQS48**** | T (LVDS)* | |
| N5 | PL38B | 6 | LDQ38 | C (LVDS)* | PL48B | 6 | LDQ48 | C (LVDS)* | |
| P1 | PL39A | 6 | LDQ38 | T | PL49A | 6 | LDQ48 | T | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| P2 | PL39B | 6 | LDQ38 | C | PL49B | 6 | LDQ48 | C | |
| P3 | PL40A | 6 | LDQ38 | T (LVDS)* | PL50A | 6 | LDQ48 | T (LVDS)* | |
| P4 | PL40B | 6 | LDQ38 | C (LVDS)* | PL50B | 6 | LDQ48 | C (LVDS)* | |
| P5 | PL41A | 6 | LDQ38 | T | PL51A | 6 | LDQ48 | T | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| P7 | PL41B | 6 | LDQ38 | C | PL51B | 6 | LDQ48 | C | |
| R1 | PL42A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | PL57A | 6 | LLM0_GPLLT_IN_A**/LDQS57**** | T (LVDS)* | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| R2 | PL42B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | PL57B | 6 | LLM0_GPLLC_IN_A**/LDQ57 | C (LVDS)* | |
| R3 | PL43A | 6 | LLM0_GPLLT_FB_A | T | PL58A | 6 | LLM0_GPLLT_FB_A/LDQ57 | T | |
| R4 | PL43B | 6 | LLM0_GPLLC_FB_A | C | PL58B | 6 | LLM0_GPLLC_FB_A/LDQ57 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| R6 | PL44A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* | PL59A | 6 | LLM0_GDLLT_IN_A**/LDQ57 | T (LVDS)* | |
| R5 | PL44B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* | PL59B | 6 | LLM0_GDLLC_IN_A**/LDQ57 | C (LVDS)* | |
| T1 | PL45A | 6 | LLM0_GDLLT_FB_A | T | PL60A | 6 | LLM0_GDLLT_FB_A/LDQ57 | T | |
| T2 | PL45B | 6 | LLM0_GDLLC_FB_A | C | PL60B | 6 | LLM0_GDLLC_FB_A/LDQ57 | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| R7 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | | |
| T6 | PL47A | 6 | LDQ51 | T (LVDS)* | PL62A | 6 | LDQ66 | T (LVDS)* | |
| T7 | PL47B | 6 | LDQ51 | C (LVDS)* | PL62B | 6 | LDQ66 | C (LVDS)* | |
| U1 | PL48A | 6 | LDQ51 | T | PL63A | 6 | LDQ66 | T | |
| U2 | PL48B | 6 | LDQ51 | C | PL63B | 6 | LDQ66 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| T3 | PL49A | 6 | LDQ51 | T (LVDS)* | PL64A | 6 | LDQ66 | T (LVDS)* | |
| U3 | PL49B | 6 | LDQ51 | C (LVDS)* | PL64B | 6 | LDQ66 | C (LVDS)* | |
| U6 | PL50A | 6 | LDQ51 | T | NC | - | | | |
| U5 | PL50B | 6 | LDQ51 | C | PL65B | 6 | LDQ66 | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| V5 | PL51A | 6 | LDQS51 | T (LVDS)* | PL66A | 6 | LDQS66 | T (LVDS)* | |
| U4 | PL51B | 6 | LDQ51 | C (LVDS)* | PL66B | 6 | LDQ66 | C (LVDS)* | |
| V1 | PL52A | 6 | LDQ51 | T | PL67A | 6 | LDQ66 | T | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| V3 | PL52B | 6 | LDQ51 | C | PL67B | 6 | LDQ66 | C | |
| W1 | PL53A | 6 | LDQ51 | T (LVDS)* | PL68A | 6 | LDQ66 | T (LVDS)* | |
| Y1 | PL53B | 6 | LDQ51 | C (LVDS)* | PL68B | 6 | LDQ66 | C (LVDS)* | |
| AA1 | PL54A | 6 | LDQ51 | T | PL69A | 6 | LDQ66 | T | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| AA2 | PL54B | 6 | LDQ51 | C | PL69B | 6 | LDQ66 | C | |
| V4 | TCK | - | | | TCK | - | | | |
| Y2 | TDI | - | | | TDI | - | | | |
| Y3 | TMS | - | | | TMS | - | | | |
| W3 | TDO | - | | | TDO | - | | | |
| W4 | VCCJ | - | | | VCCJ | - | | | |
| W5 | PB2A | 5 | BDQ6 | T | PB2A | 5 | BDQ6 | T | |
| Y4 | PB2B | 5 | BDQ6 | C | PB2B | 5 | BDQ6 | C | |
| W6 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T | |
| V6 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C | |
| AA3 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AB2 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C | |
| T8 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T | |
| U7 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C | |
| U8 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| T9 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C | |
| V8 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T | |
| W8 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C | |
| Y6 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| Y5 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C | |
| AB3 | PB9A | 5 | BDQ6 | T | PB9A | 5 | BDQ6 | T | |
| AB4 | PB9B | 5 | BDQ6 | C | PB9B | 5 | BDQ6 | C | |
| AB5 | PB10A | 5 | BDQ6 | T | PB10A | 5 | BDQ6 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AA6 | PB10B | 5 | BDQ6 | C | PB10B | 5 | BDQ6 | C | |
| V9 | PB13A | 5 | BDQ15 | T | PB31A | 5 | BDQ33 | T | |
| U9 | PB13B | 5 | BDQ15 | C | PB31B | 5 | BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| - | - | - | | | GNDIO5 | - | | | |
| U10 | PB14A | 5 | BDQ15 | T | PB32A | 5 | BDQ33 | T | |
| T10 | PB14B | 5 | BDQ15 | C | PB32B | 5 | BDQ33 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| W9 | PB15A | 5 | BDQS15**** | T | PB33A | 5 | BDQS33**** | T | |
| Y8 | PB15B | 5 | BDQ15 | C | PB33B | 5 | BDQ33 | C | |
| AA7 | PB16A | 5 | VREF2_5/BDQ15 | T | PB34A | 5 | VREF2_5/BDQ33 | T | |
| Y7 | PB16B | 5 | VREF1_5/BDQ15 | C | PB34B | 5 | VREF1_5/BDQ33 | C | |
| AB6 | PB17A | 5 | PCLKT5_0/BDQ15 | T | PB35A | 5 | PCLKT5_0/BDQ33 | T | |
| AB7 | PB17B | 5 | PCLKC5_0/BDQ15 | C | PB35B | 5 | PCLKC5_0/BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AA8 | PB22A | 4 | PCLKT4_0/BDQ24 | T | PB40A | 4 | PCLKT4_0/BDQ42 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AB8 | PB22B | 4 | PCLKC4_0/BDQ24 | C | PB40B | 4 | PCLKC4_0/BDQ42 | C | |
| AA9 | PB23A | 4 | VREF2_4/BDQ24 | T | PB41A | 4 | VREF2_4/BDQ42 | T | |
| Y9 | PB23B | 4 | VREF1_4/BDQ24 | C | PB41B | 4 | VREF1_4/BDQ42 | C | |
| AB9 | PB24A | 4 | BDQS24**** | T | PB42A | 4 | BDQS42**** | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AB10 | PB24B | 4 | BDQ24 | C | PB42B | 4 | BDQ42 | C | |
| AA10 | PB25A | 4 | BDQ24 | T | PB43A | 4 | BDQ42 | T | |
| Y11 | PB25B | 4 | BDQ24 | C | PB43B | 4 | BDQ42 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| V10 | PB29A | 4 | BDQ33 | T | PB47A | 4 | BDQ51 | T | |
| U11 | PB29B | 4 | BDQ33 | C | PB47B | 4 | BDQ51 | C | |
| V11 | PB30A | 4 | BDQ33 | T | PB48A | 4 | BDQ51 | T | |
| W11 | PB30B | 4 | BDQ33 | C | PB48B | 4 | BDQ51 | C | |
| AA11 | PB31A | 4 | BDQ33 | T | PB49A | 4 | BDQ51 | T | |
| AB11 | PB31B | 4 | BDQ33 | C | PB49B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| T11 | PB32A | 4 | BDQ33 | T | PB50A | 4 | BDQ51 | T | |
| U12 | PB32B | 4 | BDQ33 | C | PB50B | 4 | BDQ51 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA12 | PB33A | 4 | BDQS33 | T | PB51A | 4 | BDQS51 | T | |
| Y12 | PB33B | 4 | BDQ33 | C | PB51B | 4 | BDQ51 | C | |
| V12 | PB34A | 4 | BDQ33 | T | PB52A | 4 | BDQ51 | T | |
| W12 | PB34B | 4 | BDQ33 | C | PB52B | 4 | BDQ51 | C | |
| AB12 | PB35A | 4 | BDQ33 | T | PB53A | 4 | BDQ51 | T | |
| AA13 | PB35B | 4 | BDQ33 | C | PB53B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| T12 | PB36A | 4 | BDQ33 | T | PB54A | 4 | BDQ51 | T | |
| U13 | PB36B | 4 | BDQ33 | C | PB54B | 4 | BDQ51 | C | |
| V13 | PB37A | 4 | BDQ33 | T | PB55A | 4 | BDQ51 | T | |
| T13 | PB37B | 4 | BDQ33 | C | PB55B | 4 | BDQ51 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AB13 | PB38A | 4 | BDQ42 | T | PB56A | 4 | BDQ60 | T | |
| AB14 | PB38B | 4 | BDQ42 | C | PB56B | 4 | BDQ60 | C | |
| U14 | PB39A | 4 | BDQ42 | T | PB57A | 4 | BDQ60 | T | |
| T14 | PB39B | 4 | BDQ42 | C | PB57B | 4 | BDQ60 | C | |
| AA14 | PB40A | 4 | BDQ42 | T | PB58A | 4 | BDQ60 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| Y14 | PB40B | 4 | BDQ42 | C | PB58B | 4 | BDQ60 | C | |
| W14 | PB41A | 4 | BDQ42 | T | PB59A | 4 | BDQ60 | T | |
| V14 | PB41B | 4 | BDQ42 | C | PB59B | 4 | BDQ60 | C | |
| AB15 | PB42A | 4 | BDQS42 | T | PB60A | 4 | BDQS60 | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA15 | PB42B | 4 | BDQ42 | C | PB60B | 4 | BDQ60 | C | |
| V15 | PB43A | 4 | BDQ42 | T | PB61A | 4 | BDQ60 | T | |
| U15 | PB43B | 4 | BDQ42 | C | PB61B | 4 | BDQ60 | C | |
| AB16 | PB44A | 4 | BDQ42 | T | PB62A | 4 | BDQ60 | T | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AA16 | PB44B | 4 | BDQ42 | C | PB62B | 4 | BDQ60 | C | |
| AB17 | PB45A | 4 | BDQ42 | T | PB63A | 4 | BDQ60 | T | |
| AA17 | PB45B | 4 | BDQ42 | C | PB63B | 4 | BDQ60 | C | |
| Y15 | PB46A | 4 | BDQ42 | T | PB64A | 4 | BDQ60 | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| W15 | PB46B | 4 | BDQ42 | C | PB64B | 4 | BDQ60 | C | |
| AB20 | PB47A | 4 | BDQ51 | T | PB65A | 4 | BDQ69 | T | |
| AB21 | PB47B | 4 | BDQ51 | C | PB65B | 4 | BDQ69 | C | |
| AA21 | PB48A | 4 | BDQ51 | T | PB66A | 4 | BDQ69 | T | |
| AA20 | PB48B | 4 | BDQ51 | C | PB66B | 4 | BDQ69 | C | |
| AB19 | PB49A | 4 | BDQ51 | T | PB67A | 4 | BDQ69 | T | |
| AB18 | PB49B | 4 | BDQ51 | C | PB67B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| Y22 | PB50A | 4 | BDQ51 | T | PB68A | 4 | BDQ69 | T | |
| Y21 | PB50B | 4 | BDQ51 | C | PB68B | 4 | BDQ69 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| Y17 | PB51A | 4 | BDQS51 | T | PB69A | 4 | BDQS69 | T | |
| Y18 | PB51B | 4 | BDQ51 | C | PB69B | 4 | BDQ69 | C | |
| Y16 | PB52A | 4 | BDQ51 | T | PB70A | 4 | BDQ69 | T | |
| W17 | PB52B | 4 | BDQ51 | C | PB70B | 4 | BDQ69 | C | |
| Y19 | PB53A | 4 | BDQ51 | T | PB71A | 4 | BDQ69 | T | |
| Y20 | PB53B | 4 | BDQ51 | C | PB71B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| W19 | PB54A | 4 | BDQ51 | T | PB72A | 4 | BDQ69 | T | |
| W18 | PB54B | 4 | BDQ51 | C | PB72B | 4 | BDQ69 | C | |
| V17 | PB55A | 4 | BDQ51 | T | PB73A | 4 | BDQ69 | T | |
| V18 | PB55B | 4 | BDQ51 | C | PB73B | 4 | BDQ69 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| W20 | CFG2 | 8 | | | CFG2 | 8 | | | |
| V20 | CFG1 | 8 | | | CFG1 | 8 | | | |
| V19 | CFG0 | 8 | | | CFG0 | 8 | | | |
| V22 | PROGRAMN | 8 | | | PROGRAMN | 8 | | | |
| W22 | CCLK | 8 | | | CCLK | 8 | | | |
| U18 | INITN | 8 | | | INITN | 8 | | | |
| U22 | DONE | 8 | | | DONE | 8 | | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | | |
| U20 | PR53B | 8 | WRITEN*** | C | PR68B | 8 | WRITEN*** | C | |
| U21 | PR53A | 8 | CS1N*** | T | PR68A | 8 | CS1N*** | T | |
| U17 | PR52B | 8 | CSN*** | C | PR67B | 8 | CSN*** | C | |
| U16 | PR52A | 8 | D0/SPIFASTN*** | T | PR67A | 8 | D0/SPIFASTN*** | T | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| T16 | PR51B | 8 | D1*** | C | PR66B | 8 | D1*** | C | |
| T17 | PR51A | 8 | D2*** | T | PR66A | 8 | D2*** | T | |
| T22 | PR50B | 8 | D3*** | C | PR65B | 8 | D3*** | C | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | | |
| R22 | PR50A | 8 | D4*** | T | PR65A | 8 | D4*** | T | |
| T15 | PR49B | 8 | D5*** | C | PR64B | 8 | D5*** | C | |
| R17 | PR49A | 8 | D6*** | T | PR64A | 8 | D6*** | T | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|---------------------|--------------|-------------------|------|----------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| T20 | PR48B | 8 | D7/SPID0*** | C | PR63B | 8 | D7/SPID0*** | C | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | | |
| T21 | PR48A | 8 | DI/CSSPI0N*** | T | PR63A | 8 | DI/CSSPI0N*** | T | |
| R21 | PR47B | 8 | DOU/CSON/CSSPI1N*** | C | PR62B | 8 | DOU/CSON/CSSPI1N*** | C | |
| R20 | PR47A | 8 | BUSY/SISPI*** | T | PR62A | 8 | BUSY/SISPI*** | T | |
| R16 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | | |
| R18 | PR45B | 3 | RLM0_GDLLC_FB_A | C | PR60B | 3 | RLM0_GDLLC_FB_A/RDQ57 | C | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| R19 | PR45A | 3 | RLM0_GDLLT_FB_A | T | PR60A | 3 | RLM0_GDLLT_FB_A/RDQ57 | T | |
| P22 | PR44B | 3 | RLM0_GDLLC_IN_A** | C (LVDS)* | PR59B | 3 | RLM0_GDLLC_IN_A**/RDQ57 | C (LVDS)* | |
| P21 | PR44A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* | PR59A | 3 | RLM0_GDLLT_IN_A**/RDQ57 | T (LVDS)* | |
| P16 | PR43B | 3 | RLM0_GPLLC_IN_A** | C | PR58B | 3 | RLM0_GPLLC_IN_A**/RDQ57 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| P17 | PR43A | 3 | RLM0_GPLLT_IN_A** | T | PR58A | 3 | RLM0_GPLLT_IN_A**/RDQ57 | T | |
| P20 | PR42B | 3 | RLM0_GPLLC_FB_A | C (LVDS)* | PR57B | 3 | RLM0_GPLLC_FB_A/RDQ57 | C (LVDS)* | |
| P19 | PR42A | 3 | RLM0_GPLLT_FB_A | T (LVDS)* | PR57A | 3 | RLM0_GPLLT_FB_A/RDQS57**** | T (LVDS)* | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| - | - | - | | | VCCIO3 | 3 | | | |
| P18 | PR41B | 3 | RDQ38 | C | PR51B | 3 | RDQ48 | C | |
| N16 | PR41A | 3 | RDQ38 | T | PR51A | 3 | RDQ48 | T | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| N22 | PR40B | 3 | RDQ38 | C (LVDS)* | PR50B | 3 | RDQ48 | C (LVDS)* | |
| N21 | PR40A | 3 | RDQ38 | T (LVDS)* | PR50A | 3 | RDQ48 | T (LVDS)* | |
| N17 | PR39B | 3 | RDQ38 | C | PR49B | 3 | RDQ48 | C | |
| N18 | PR39A | 3 | RDQ38 | T | PR49A | 3 | RDQ48 | T | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| M22 | PR38B | 3 | RDQ38 | C (LVDS)* | PR48B | 3 | RDQ48 | C (LVDS)* | |
| M21 | PR38A | 3 | RDQS38 | T (LVDS)* | PR48A | 3 | RDQS48 | T (LVDS)* | |
| M16 | PR37B | 3 | RDQ38 | C | PR47B | 3 | RDQ48 | C | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| M17 | PR37A | 3 | RDQ38 | T | PR47A | 3 | RDQ48 | T | |
| M20 | PR36B | 3 | RDQ38 | C (LVDS)* | PR46B | 3 | RDQ48 | C (LVDS)* | |
| M19 | PR36A | 3 | RDQ38 | T (LVDS)* | PR46A | 3 | RDQ48 | T (LVDS)* | |
| M18 | PR35B | 3 | RDQ38 | C | PR45B | 3 | RDQ48 | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| L16 | PR35A | 3 | RDQ38 | T | PR45A | 3 | RDQ48 | T | |
| L22 | PR34B | 3 | RDQ38 | C (LVDS)* | PR44B | 3 | RDQ48 | C (LVDS)* | |
| L21 | PR34A | 3 | RDQ38 | T (LVDS)* | PR44A | 3 | RDQ48 | T (LVDS)* | |
| K22 | PR32B | 3 | RLM1_SPLLC_FB_A | C | PR42B | 3 | RLM2_SPLLC_FB_A | C | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| K21 | PR32A | 3 | RLM1_SPLLT_FB_A | T | PR42A | 3 | RLM2_SPLLT_FB_A | T | |
| L17 | PR31B | 3 | RLM1_SPLLC_IN_A | C (LVDS)* | PR41B | 3 | RLM2_SPLLC_IN_A | C (LVDS)* | |
| L18 | PR31A | 3 | RLM1_SPLLT_IN_A | T (LVDS)* | PR41A | 3 | RLM2_SPLLT_IN_A | T (LVDS)* | |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | | |
| L20 | PR30B | 3 | | C | PR40B | 3 | | C | |
| L19 | PR30A | 3 | | T | PR40A | 3 | | T | |
| K16 | PR29B | 3 | | C (LVDS)* | PR39B | 3 | | C (LVDS)* | |
| K17 | PR29A | 3 | | T (LVDS)* | PR39A | 3 | | T (LVDS)* | |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|------------------------|--------------|-------------------|------|------------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| J16 | PR28B | 3 | VREF2_3 | C | PR38B | 3 | VREF2_3 | C | |
| K18 | PR28A | 3 | VREF1_3 | T | PR38A | 3 | VREF1_3 | T | |
| J22 | PR27B | 3 | PCLKC3_0 | C (LVDS)* | PR37B | 3 | PCLKC3_0 | C (LVDS)* | |
| J21 | PR27A | 3 | PCLKT3_0 | T (LVDS)* | PR37A | 3 | PCLKT3_0 | T (LVDS)* | |
| H22 | PR25B | 2 | PCLKC2_0/RDQ22 | C | PR35B | 2 | PCLKC2_0/RDQ32 | C | |
| H21 | PR25A | 2 | PCLKT2_0/RDQ22 | T | PR35A | 2 | PCLKT2_0/RDQ32 | T | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| J17 | PR24B | 2 | RDQ22 | C (LVDS)* | PR34B | 2 | RDQ32 | C (LVDS)* | |
| J18 | PR24A | 2 | RDQ22 | T (LVDS)* | PR34A | 2 | RDQ32 | T (LVDS)* | |
| J20 | PR23B | 2 | RDQ22 | C | PR33B | 2 | RDQ32 | C | |
| J19 | PR23A | 2 | RDQ22 | T | PR33A | 2 | RDQ32 | T | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| H16 | PR22B | 2 | RDQ22 | C (LVDS)* | PR32B | 2 | RDQ32 | C (LVDS)* | |
| H17 | PR22A | 2 | RDQS22 | T (LVDS)* | PR32A | 2 | RDQS32 | T (LVDS)* | |
| G22 | PR21B | 2 | RDQ22 | C | PR31B | 2 | RDQ32 | C | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| G21 | PR21A | 2 | RDQ22 | T | PR31A | 2 | RDQ32 | T | |
| H20 | PR20B | 2 | RDQ22 | C (LVDS)* | PR30B | 2 | RDQ32 | C (LVDS)* | |
| H19 | PR20A | 2 | RDQ22 | T (LVDS)* | PR30A | 2 | RDQ32 | T (LVDS)* | |
| G16 | PR19B | 2 | RUM1_SPLL_C_FB_A/RDQ22 | C | PR29B | 2 | RUM1_SPLL_C_FB_A/RDQ32 | C | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| H18 | PR19A | 2 | RUM1_SPLL_T_FB_A/RDQ22 | T | PR29A | 2 | RUM1_SPLL_T_FB_A/RDQ32 | T | |
| F22 | PR18B | 2 | RUM1_SPLL_C_IN_A/RDQ22 | C (LVDS)* | PR28B | 2 | RUM1_SPLL_C_IN_A/RDQ32 | C (LVDS)* | |
| F21 | PR18A | 2 | RUM1_SPLL_T_IN_A/RDQ22 | T (LVDS)* | PR28A | 2 | RUM1_SPLL_T_IN_A/RDQ32 | T (LVDS)* | |
| GNDIO | GNDIO2 | - | | | - | - | | | |
| G20 | PR16B | 2 | | C | PR26B | 2 | RDQ23 | C | |
| VCCIO | VCCIO2 | 2 | | | - | - | | | |
| F20 | PR16A | 2 | | T | PR26A | 2 | RDQ23 | T | |
| - | - | - | | | GNDIO2 | - | | | |
| G17 | PR15B | 2 | | C (LVDS)* | PR25B | 2 | RDQ23 | C (LVDS)* | |
| F17 | PR15A | 2 | | T (LVDS)* | PR25A | 2 | RDQ23 | T (LVDS)* | |
| - | - | - | | | VCCIO2 | 2 | | | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| E22 | PR14B | 2 | | C | PR14B | 2 | RDQ15 | C | |
| D22 | PR14A | 2 | | T | PR14A | 2 | RDQ15 | T | |
| E20 | PR13B | 2 | | C (LVDS)* | PR13B | 2 | RDQ15 | C (LVDS)* | |
| D20 | PR13A | 2 | | T (LVDS)* | PR13A | 2 | RDQ15 | T (LVDS)* | |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| D19 | PR12B | 2 | RUM0_SPLL_C_FB_A | C | PR12B | 2 | RUM0_SPLL_C_FB_A/RDQ15 | C | |
| E19 | PR12A | 2 | RUM0_SPLL_T_FB_A | T | PR12A | 2 | RUM0_SPLL_T_FB_A/RDQ15 | T | |
| F18 | PR11B | 2 | RUM0_SPLL_C_IN_A | C (LVDS)* | PR11B | 2 | RUM0_SPLL_C_IN_A/RDQ15 | C (LVDS)* | |
| F19 | PR11A | 2 | RUM0_SPLL_T_IN_A | T (LVDS)* | PR11A | 2 | RUM0_SPLL_T_IN_A/RDQ15 | T (LVDS)* | |
| E18 | PR9B | 2 | VREF2_2 | C | PR9B | 2 | VREF2_2 | C | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| D18 | PR9A | 2 | VREF1_2 | T | PR9A | 2 | VREF1_2 | T | |
| VCCIO | VCCIO2 | 2 | | | - | - | | | |
| F16 | XRES | - | | | XRES | - | | | |
| C22 | URC_SQ_VCCR_X0 | 12 | | | URC_SQ_VCCR_X0 | 12 | | | |
| A21 | URC_SQ_HDIN_P0 | 12 | | T | URC_SQ_HDIN_P0 | 12 | | T | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-----------------------------|------|---------------|--------------|-----------------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| B22 | URC_SQ_VCCIB0 | 12 | | | URC_SQ_VCCIB0 | 12 | | | |
| B21 | URC_SQ_HDINN0 | 12 | | C | URC_SQ_HDINN0 | 12 | | C | |
| C19 | URC_SQ_VCCTX0 | 12 | | | URC_SQ_VCCTX0 | 12 | | | |
| A18 | URC_SQ_HDOUPT ₀ | 12 | | T | URC_SQ_HDOUPT ₀ | 12 | | T | |
| A19 | URC_SQ_VCCOB0 | 12 | | | URC_SQ_VCCOB0 | 12 | | | |
| B18 | URC_SQ_HDOUPTN ₀ | 12 | | C | URC_SQ_HDOUPTN ₀ | 12 | | C | |
| C18 | URC_SQ_VCCTX1 | 12 | | | URC_SQ_VCCTX1 | 12 | | | |
| B17 | URC_SQ_HDOUPTN ₁ | 12 | | C | URC_SQ_HDOUPTN ₁ | 12 | | C | |
| C17 | URC_SQ_VCCOB1 | 12 | | | URC_SQ_VCCOB1 | 12 | | | |
| A17 | URC_SQ_HDOUPT ₁ | 12 | | T | URC_SQ_HDOUPT ₁ | 12 | | T | |
| C21 | URC_SQ_VCCRX1 | 12 | | | URC_SQ_VCCRX1 | 12 | | | |
| B20 | URC_SQ_HDINN1 | 12 | | C | URC_SQ_HDINN1 | 12 | | C | |
| C20 | URC_SQ_VCCIB1 | 12 | | | URC_SQ_VCCIB1 | 12 | | | |
| A20 | URC_SQ_HDINP1 | 12 | | T | URC_SQ_HDINP1 | 12 | | T | |
| B16 | URC_SQ_VCCAUX ₃₃ | 12 | | | URC_SQ_VCCAUX ₃₃ | 12 | | | |
| E17 | URC_SQ_REFCLK _N | 12 | | C | URC_SQ_REFCLK _N | 12 | | C | |
| D17 | URC_SQ_REFCLK _P | 12 | | T | URC_SQ_REFCLK _P | 12 | | T | |
| C16 | URC_SQ_VCCP | 12 | | | URC_SQ_VCCP | 12 | | | |
| A12 | URC_SQ_HDINP2 | 12 | | T | URC_SQ_HDINP2 | 12 | | T | |
| C12 | URC_SQ_VCCIB2 | 12 | | | URC_SQ_VCCIB2 | 12 | | | |
| B12 | URC_SQ_HDINN2 | 12 | | C | URC_SQ_HDINN2 | 12 | | C | |
| C11 | URC_SQ_VCCRX2 | 12 | | | URC_SQ_VCCRX2 | 12 | | | |
| A15 | URC_SQ_HDOUPT ₂ | 12 | | T | URC_SQ_HDOUPT ₂ | 12 | | T | |
| C15 | URC_SQ_VCCOB2 | 12 | | | URC_SQ_VCCOB2 | 12 | | | |
| B15 | URC_SQ_HDOUPTN ₂ | 12 | | C | URC_SQ_HDOUPTN ₂ | 12 | | C | |
| C14 | URC_SQ_VCCTX2 | 12 | | | URC_SQ_VCCTX2 | 12 | | | |
| B14 | URC_SQ_HDOUPTN ₃ | 12 | | C | URC_SQ_HDOUPTN ₃ | 12 | | C | |
| A13 | URC_SQ_VCCOB3 | 12 | | | URC_SQ_VCCOB3 | 12 | | | |
| A14 | URC_SQ_HDOUPT ₃ | 12 | | T | URC_SQ_HDOUPT ₃ | 12 | | T | |
| C13 | URC_SQ_VCCTX3 | 12 | | | URC_SQ_VCCTX3 | 12 | | | |
| B11 | URC_SQ_HDINN3 | 12 | | C | URC_SQ_HDINN3 | 12 | | C | |
| B10 | URC_SQ_VCCIB3 | 12 | | | URC_SQ_VCCIB3 | 12 | | | |
| A11 | URC_SQ_HDINP3 | 12 | | T | URC_SQ_HDINP3 | 12 | | T | |
| C10 | URC_SQ_VCCRX3 | 12 | | | URC_SQ_VCCRX3 | 12 | | | |
| E13 | PT28B | 1 | | C | PT46B | 1 | | C | |
| D12 | PT28A | 1 | | T | PT46A | 1 | | T | |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | | |
| A9 | PT27B | 1 | | C | PT45B | 1 | | C | |
| A8 | PT27A | 1 | | T | PT45A | 1 | | T | |
| A7 | PT26B | 1 | | C | PT44B | 1 | | C | |
| A6 | PT26A | 1 | | T | PT44A | 1 | | T | |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| E12 | PT25B | 1 | | C | PT43B | 1 | | C | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F12 | PT25A | 1 | | T | PT43A | 1 | | T |
| A5 | PT24B | 1 | | C | PT42B | 1 | | C |
| A4 | PT24A | 1 | | T | PT42A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| B7 | PT23B | 1 | | C | PT41B | 1 | | C |
| B8 | PT23A | 1 | | T | PT41A | 1 | | T |
| G11 | PT22B | 1 | | C | PT40B | 1 | | C |
| E11 | PT22A | 1 | | T | PT40A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D11 | PT21B | 1 | VREF2_1 | C | PT39B | 1 | VREF2_1 | C |
| D10 | PT21A | 1 | VREF1_1 | T | PT39A | 1 | VREF1_1 | T |
| F11 | PT20A | 1 | PCLKT1_0 | T | PT38A | 1 | PCLKT1_0 | T |
| G10 | PT20B | 1 | PCLKC1_0 | C | PT38B | 1 | PCLKC1_0 | C |
| G9 | PT19B | 0 | PCLKC0_0 | C | PT37B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| F9 | PT19A | 0 | PCLKT0_0 | T | PT37A | 0 | PCLKT0_0 | T |
| C9 | PT18B | 0 | VREF2_0 | C | PT36B | 0 | VREF2_0 | C |
| D9 | PT18A | 0 | VREF1_0 | T | PT36A | 0 | VREF1_0 | T |
| A2 | PT17B | 0 | | C | PT35B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| A3 | PT17A | 0 | | T | PT35A | 0 | | T |
| B3 | PT16B | 0 | | C | PT34B | 0 | | C |
| C4 | PT16A | 0 | | T | PT34A | 0 | | T |
| E10 | PT15B | 0 | | C | PT33B | 0 | | C |
| F10 | PT15A | 0 | | T | PT33A | 0 | | T |
| C7 | PT14B | 0 | | C | PT32B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| B6 | PT14A | 0 | | T | PT32A | 0 | | T |
| C6 | PT13B | 0 | | C | PT31B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C5 | PT13A | 0 | | T | PT31A | 0 | | T |
| C8 | PT12B | 0 | | C | PT30B | 0 | | C |
| D8 | PT12A | 0 | | T | PT30A | 0 | | T |
| E8 | PT11B | 0 | | C | PT29B | 0 | | C |
| E9 | PT11A | 0 | | T | PT29A | 0 | | T |
| - | - | - | | | GNDIO0 | - | | |
| - | - | - | | | VCCIO0 | 0 | | |
| F8 | PT10B | 0 | | C | PT10B | 0 | | C |
| G8 | PT10A | 0 | | T | PT10A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| F7 | PT9B | 0 | | C | PT9B | 0 | | C |
| G7 | PT9A | 0 | | T | PT9A | 0 | | T |
| C3 | PT8B | 0 | | C | PT8B | 0 | | C |
| D4 | PT8A | 0 | | T | PT8A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F6 | PT7B | 0 | | C | PT7B | 0 | | C |
| E6 | PT7A | 0 | | T | PT7A | 0 | | T |
| E5 | PT6B | 0 | | C | PT6B | 0 | | C |
| D6 | PT6A | 0 | | T | PT6A | 0 | | T |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | | |
| D3 | PT5B | 0 | | C | PT5B | 0 | | C | |
| E3 | PT5A | 0 | | T | PT5A | 0 | | T | |
| D5 | PT4B | 0 | | C | PT4B | 0 | | C | |
| E4 | PT4A | 0 | | T | PT4A | 0 | | T | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| C2 | PT3B | 0 | | C | PT3B | 0 | | C | |
| B2 | PT3A | 0 | | T | PT3A | 0 | | T | |
| B1 | PT2B | 0 | | C | PT2B | 0 | | C | |
| C1 | PT2A | 0 | | T | PT2A | 0 | | T | |
| R8 | VCCPLL | - | | | VCCPLL | - | | | |
| H15 | VCCPLL | - | | | VCCPLL | - | | | |
| H8 | VCCPLL | - | | | VCCPLL | - | | | |
| R15 | VCCPLL | - | | | VCCPLL | - | | | |
| J10 | VCC | - | | | VCC | - | | | |
| J11 | VCC | - | | | VCC | - | | | |
| J12 | VCC | - | | | VCC | - | | | |
| J13 | VCC | - | | | VCC | - | | | |
| K14 | VCC | - | | | VCC | - | | | |
| K9 | VCC | - | | | VCC | - | | | |
| L14 | VCC | - | | | VCC | - | | | |
| L9 | VCC | - | | | VCC | - | | | |
| M14 | VCC | - | | | VCC | - | | | |
| M9 | VCC | - | | | VCC | - | | | |
| N14 | VCC | - | | | VCC | - | | | |
| N9 | VCC | - | | | VCC | - | | | |
| P10 | VCC | - | | | VCC | - | | | |
| P11 | VCC | - | | | VCC | - | | | |
| P12 | VCC | - | | | VCC | - | | | |
| P13 | VCC | - | | | VCC | - | | | |
| B5 | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| B9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| E7 | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| H9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | | |
| D13 | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| E16 | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| H14 | VCCIO1 | 1 | | | VCCIO1 | 1 | | | |
| E21 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| G18 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| J15 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| K19 | VCCIO2 | 2 | | | VCCIO2 | 2 | | | |
| N19 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| P15 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| T18 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| V21 | VCCIO3 | 3 | | | VCCIO3 | 3 | | | |
| AA18 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| R14 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| V16 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| W13 | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AA5 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| R9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| V7 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| W10 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| N4 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| P8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| T5 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V2 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| E2 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| G5 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J8 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K4 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| AA22 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| U19 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| H11 | VCCAUX | - | | | VCCAUX | - | | |
| H12 | VCCAUX | - | | | VCCAUX | - | | |
| L15 | VCCAUX | - | | | VCCAUX | - | | |
| L8 | VCCAUX | - | | | VCCAUX | - | | |
| M15 | VCCAUX | - | | | VCCAUX | - | | |
| M8 | VCCAUX | - | | | VCCAUX | - | | |
| R11 | VCCAUX | - | | | VCCAUX | - | | |
| R12 | VCCAUX | - | | | VCCAUX | - | | |
| A1 | GND | - | | | GND | - | | |
| A10 | GND | - | | | GND | - | | |
| A16 | GND | - | | | GND | - | | |
| A22 | GND | - | | | GND | - | | |
| AA19 | GND | - | | | GND | - | | |
| AA4 | GND | - | | | GND | - | | |
| AB1 | GND | - | | | GND | - | | |
| AB22 | GND | - | | | GND | - | | |
| B13 | GND | - | | | GND | - | | |
| B19 | GND | - | | | GND | - | | |
| B4 | GND | - | | | GND | - | | |
| D16 | GND | - | | | GND | - | | |
| D2 | GND | - | | | GND | - | | |
| D21 | GND | - | | | GND | - | | |
| D7 | GND | - | | | GND | - | | |
| G19 | GND | - | | | GND | - | | |
| G4 | GND | - | | | GND | - | | |
| H10 | GND | - | | | GND | - | | |
| H13 | GND | - | | | GND | - | | |
| J14 | GND | - | | | GND | - | | |
| J9 | GND | - | | | GND | - | | |
| K10 | GND | - | | | GND | - | | |
| K11 | GND | - | | | GND | - | | |
| K12 | GND | - | | | GND | - | | |
| K13 | GND | - | | | GND | - | | |
| K15 | GND | - | | | GND | - | | |
| K20 | GND | - | | | GND | - | | |

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

| LFE2M20E/SE | | | | | LFE2M35E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| K3 | GND | - | | | GND | - | | |
| K8 | GND | - | | | GND | - | | |
| L10 | GND | - | | | GND | - | | |
| L11 | GND | - | | | GND | - | | |
| L12 | GND | - | | | GND | - | | |
| L13 | GND | - | | | GND | - | | |
| M10 | GND | - | | | GND | - | | |
| M11 | GND | - | | | GND | - | | |
| M12 | GND | - | | | GND | - | | |
| M13 | GND | - | | | GND | - | | |
| N10 | GND | - | | | GND | - | | |
| N11 | GND | - | | | GND | - | | |
| N12 | GND | - | | | GND | - | | |
| N13 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N20 | GND | - | | | GND | - | | |
| N3 | GND | - | | | GND | - | | |
| N8 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P9 | GND | - | | | GND | - | | |
| R10 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| T19 | GND | - | | | GND | - | | |
| T4 | GND | - | | | GND | - | | |
| W16 | GND | - | | | GND | - | | |
| W2 | GND | - | | | GND | - | | |
| W21 | GND | - | | | GND | - | | |
| W7 | GND | - | | | GND | - | | |
| Y10 | GND | - | | | GND | - | | |
| Y13 | GND | - | | | GND | - | | |
| D15 | NC | - | | | NC | - | | |
| G14 | NC | - | | | NC | - | | |
| G15 | NC | - | | | NC | - | | |
| D14 | NC | - | | | NC | - | | |
| E15 | NC | - | | | NC | - | | |
| E14 | NC | - | | | NC | - | | |
| F15 | NC | - | | | NC | - | | |
| F14 | NC | - | | | NC | - | | |
| F13 | NC | - | | | NC | - | | |
| G12 | NC | - | | | NC | - | | |
| G13 | NC | - | | | NC | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated sysCONFIG pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE Logic Signal Connections: 484 fpBGA

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| D1 | PL2A | 7 | LDQ6 | T (LVDS)* |
| E1 | PL2B | 7 | LDQ6 | C (LVDS)* |
| F1 | PL3A | 7 | LDQ6 | T |
| F2 | PL3B | 7 | LDQ6 | C |
| F5 | PL4A | 7 | LDQ6 | T (LVDS)* |
| VCCIO | VCCIO7 | 7 | | |
| G6 | PL4B | 7 | LDQ6 | C (LVDS)* |
| F4 | PL5A | 7 | LDQ6 | T |
| F3 | PL5B | 7 | LDQ6 | C |
| G1 | PL6A | 7 | LDQS6 | T (LVDS)* |
| GNDIO | GNDIO7 | - | | |
| G2 | PL6B | 7 | LDQ6 | C (LVDS)* |
| H1 | PL7A | 7 | LDQ6 | T |
| H2 | PL7B | 7 | LDQ6 | C |
| VCCIO | VCCIO7 | 7 | | |
| H7 | PL8A | 7 | LDQ6 | T (LVDS)* |
| H6 | PL8B | 7 | LDQ6 | C (LVDS)* |
| G3 | PL9A | 7 | VREF2_7/LDQ6 | T |
| H3 | PL9B | 7 | VREF1_7/LDQ6 | C |
| GNDIO | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | |
| H5 | PL11A | 7 | LUM0_SPLLT_IN_A | T (LVDS)* |
| H4 | PL11B | 7 | LUM0_SPLLC_IN_A | C (LVDS)* |
| J1 | PL12A | 7 | LUM0_SPLLT_FB_A | T |
| J2 | PL12B | 7 | LUM0_SPLLC_FB_A | C |
| GNDIO | GNDIO7 | - | | |
| J3 | PL13A | 7 | | T (LVDS)* |
| J4 | PL13B | 7 | | C (LVDS)* |
| J7 | PL14A | 7 | | T |
| VCCIO | VCCIO7 | 7 | | |
| J6 | PL14B | 7 | | C |
| GNDIO | GNDIO7 | - | | |
| VCCIO | VCCIO7 | 7 | | |
| K1 | PL32A | 7 | LUM3_SPLLT_IN_A/LDQ36 | T (LVDS)* |
| K2 | PL32B | 7 | LUM3_SPLLC_IN_A/LDQ36 | C (LVDS)* |
| J5 | PL33A | 7 | LUM3_SPLLT_FB_A/LDQ36 | T |
| K5 | PL33B | 7 | LUM3_SPLLC_FB_A/LDQ36 | C |
| VCCIO | VCCIO7 | 7 | | |
| K7 | PL34A | 7 | LDQ36 | T (LVDS)* |
| K6 | PL34B | 7 | LDQ36 | C (LVDS)* |
| L6 | PL35A | 7 | LDQ36 | T |
| L7 | PL35B | 7 | LDQ36 | C |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|-------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| GNDIO | GNDIO7 | - | | |
| L1 | PL36A | 7 | LDQS36 | T (LVDS)* |
| L2 | PL36B | 7 | LDQ36 | C (LVDS)* |
| M7 | PL37A | 7 | LDQ36 | T |
| VCCIO | VCCIO7 | 7 | | |
| L5 | PL37B | 7 | LDQ36 | C |
| L3 | PL38A | 7 | LDQ36 | T (LVDS)* |
| L4 | PL38B | 7 | LDQ36 | C (LVDS)* |
| M1 | PL39A | 7 | PCLKT7_0/LDQ36 | T |
| GNDIO | GNDIO7 | - | | |
| M2 | PL39B | 7 | PCLKC7_0/LDQ36 | C |
| M6 | PL41A | 6 | PCLKT6_0 | T (LVDS)* |
| M5 | PL41B | 6 | PCLKC6_0 | C (LVDS)* |
| M3 | PL42A | 6 | VREF2_6 | T |
| M4 | PL42B | 6 | VREF1_6 | C |
| VCCIO | VCCIO6 | 6 | | |
| N7 | PL45A | 6 | LLM3_SPLLT_IN_A | T (LVDS)* |
| GNDIO | GNDIO6 | - | | |
| N6 | PL45B | 6 | LLM3_SPLLC_IN_A | C (LVDS)* |
| N1 | PL46A | 6 | LLM3_SPLLT_FB_A | T |
| N2 | PL46B | 6 | LLM3_SPLLC_FB_A | C |
| VCCIO | VCCIO6 | 6 | | |
| GNDIO | GNDIO6 | - | | |
| P6 | PL52A | 6 | LDQS52**** | T (LVDS)* |
| N5 | PL52B | 6 | LDQ52 | C (LVDS)* |
| P1 | PL53A | 6 | LDQ52 | T |
| VCCIO | VCCIO6 | 6 | | |
| P2 | PL53B | 6 | LDQ52 | C |
| P3 | PL54A | 6 | LDQ52 | T (LVDS)* |
| P4 | PL54B | 6 | LDQ52 | C (LVDS)* |
| P5 | PL55A | 6 | LDQ52 | T |
| GNDIO | GNDIO6 | - | | |
| P7 | PL55B | 6 | LDQ52 | C |
| VCCIO | VCCIO6 | 6 | | |
| GNDIO | GNDIO6 | - | | |
| R1 | PL62A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* |
| GNDIO | GNDIO6 | - | | |
| R2 | PL62B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* |
| R3 | PL63A | 6 | LLM0_GPLLT_FB_A | T |
| R4 | PL63B | 6 | LLM0_GPLLC_FB_A | C |
| VCCIO | VCCIO6 | 6 | | |
| R6 | PL64A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* |
| R5 | PL64B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|-----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| T1 | PL65A | 6 | LLM0_GDLLT_FB_A | T |
| T2 | PL65B | 6 | LLM0_GDLLC_FB_A | C |
| GNDIO | GNDIO6 | - | | |
| R7 | LLM0_PLLCAP | 6 | | |
| T6 | PL67A | 6 | LDQ71 | T (LVDS)* |
| T7 | PL67B | 6 | LDQ71 | C (LVDS)* |
| U1 | PL68A | 6 | LDQ71 | T |
| U2 | PL68B | 6 | LDQ71 | C |
| VCCIO | VCCIO6 | 6 | | |
| T3 | PL69A | 6 | LDQ71 | T (LVDS)* |
| U3 | PL69B | 6 | LDQ71 | C (LVDS)* |
| U6 | PL70A | 6 | LDQ71 | T |
| U5 | PL70B | 6 | LDQ71 | C |
| GNDIO | GNDIO6 | - | | |
| V5 | PL71A | 6 | LDQS71 | T (LVDS)* |
| U4 | PL71B | 6 | LDQ71 | C (LVDS)* |
| V1 | PL72A | 6 | LDQ71 | T |
| VCCIO | VCCIO6 | 6 | | |
| V3 | PL72B | 6 | LDQ71 | C |
| W1 | PL73A | 6 | LDQ71 | T (LVDS)* |
| Y1 | PL73B | 6 | LDQ71 | C (LVDS)* |
| AA1 | PL74A | 6 | LDQ71 | T |
| GNDIO | GNDIO6 | - | | |
| AA2 | PL74B | 6 | LDQ71 | C |
| V4 | TCK | - | | |
| Y2 | TDI | - | | |
| Y3 | TMS | - | | |
| W3 | TDO | - | | |
| W4 | VCCJ | - | | |
| W5 | PB2A | 5 | BDQ6 | T |
| Y4 | PB2B | 5 | BDQ6 | C |
| W6 | PB3A | 5 | BDQ6 | T |
| V6 | PB3B | 5 | BDQ6 | C |
| AA3 | PB4A | 5 | BDQ6 | T |
| AB2 | PB4B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | |
| T8 | PB5A | 5 | BDQ6 | T |
| U7 | PB5B | 5 | BDQ6 | C |
| GNDIO | GNDIO5 | - | | |
| U8 | PB6A | 5 | BDQS6 | T |
| T9 | PB6B | 5 | BDQ6 | C |
| V8 | PB7A | 5 | BDQ6 | T |
| W8 | PB7B | 5 | BDQ6 | C |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| Y6 | PB8A | 5 | BDQ6 | T |
| Y5 | PB8B | 5 | BDQ6 | C |
| VCCIO | VCCIO5 | 5 | | |
| AB3 | PB9A | 5 | BDQ6 | T |
| AB4 | PB9B | 5 | BDQ6 | C |
| AB5 | PB10A | 5 | BDQ6 | T |
| AA6 | PB10B | 5 | BDQ6 | C |
| GNDIO | GNDIO5 | - | | |
| VCCIO | VCCIO5 | 5 | | |
| V9 | PB40A | 5 | BDQ42 | T |
| U9 | PB40B | 5 | BDQ42 | C |
| VCCIO | VCCIO5 | 5 | | |
| U10 | PB41A | 5 | BDQ42 | T |
| T10 | PB41B | 5 | BDQ42 | C |
| GNDIO | GNDIO5 | - | | |
| W9 | PB42A | 5 | BDQS42**** | T |
| Y8 | PB42B | 5 | BDQ42 | C |
| AA7 | PB43A | 5 | VREF2_5/BDQ42 | T |
| Y7 | PB43B | 5 | VREF1_5/BDQ42 | C |
| AB6 | PB44A | 5 | PCLKT5_0/BDQ42 | T |
| AB7 | PB44B | 5 | PCLKC5_0/BDQ42 | C |
| VCCIO | VCCIO5 | 5 | | |
| GNDIO | GNDIO5 | - | | |
| AA8 | PB49A | 4 | PCLKT4_0/BDQ51 | T |
| VCCIO | VCCIO4 | 4 | | |
| AB8 | PB49B | 4 | PCLKC4_0/BDQ51 | C |
| AA9 | PB50A | 4 | VREF2_4/BDQ51 | T |
| Y9 | PB50B | 4 | VREF1_4/BDQ51 | C |
| AB9 | PB51A | 4 | BDQS51**** | T |
| GNDIO | GNDIO4 | - | | |
| AB10 | PB51B | 4 | BDQ51 | C |
| AA10 | PB52A | 4 | BDQ51 | T |
| Y11 | PB52B | 4 | BDQ51 | C |
| VCCIO | VCCIO4 | 4 | | |
| GNDIO | GNDIO4 | - | | |
| V10 | PB56A | 4 | BDQ60 | T |
| U11 | PB56B | 4 | BDQ60 | C |
| V11 | PB57A | 4 | BDQ60 | T |
| W11 | PB57B | 4 | BDQ60 | C |
| AA11 | PB58A | 4 | BDQ60 | T |
| AB11 | PB58B | 4 | BDQ60 | C |
| VCCIO | VCCIO4 | 4 | | |
| T11 | PB59A | 4 | BDQ60 | T |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| U12 | PB59B | 4 | BDQ60 | C |
| GNDIO | GNDIO4 | - | | |
| AA12 | PB60A | 4 | BDQS60 | T |
| Y12 | PB60B | 4 | BDQ60 | C |
| V12 | PB61A | 4 | BDQ60 | T |
| W12 | PB61B | 4 | BDQ60 | C |
| AB12 | PB62A | 4 | BDQ60 | T |
| AA13 | PB62B | 4 | BDQ60 | C |
| VCCIO | VCCIO4 | 4 | | |
| T12 | PB63A | 4 | BDQ60 | T |
| U13 | PB63B | 4 | BDQ60 | C |
| V13 | PB64A | 4 | BDQ60 | T |
| T13 | PB64B | 4 | BDQ60 | C |
| GNDIO | GNDIO4 | - | | |
| AB13 | PB65A | 4 | BDQ69 | T |
| AB14 | PB65B | 4 | BDQ69 | C |
| U14 | PB66A | 4 | BDQ69 | T |
| T14 | PB66B | 4 | BDQ69 | C |
| AA14 | PB67A | 4 | BDQ69 | T |
| VCCIO | VCCIO4 | 4 | | |
| Y14 | PB67B | 4 | BDQ69 | C |
| W14 | PB68A | 4 | BDQ69 | T |
| V14 | PB68B | 4 | BDQ69 | C |
| AB15 | PB69A | 4 | BDQS69 | T |
| GNDIO | GNDIO4 | - | | |
| AA15 | PB69B | 4 | BDQ69 | C |
| V15 | PB70A | 4 | BDQ69 | T |
| U15 | PB70B | 4 | BDQ69 | C |
| AB16 | PB71A | 4 | BDQ69 | T |
| VCCIO | VCCIO4 | 4 | | |
| AA16 | PB71B | 4 | BDQ69 | C |
| AB17 | PB72A | 4 | BDQ69 | T |
| AA17 | PB72B | 4 | BDQ69 | C |
| GNDIO | GNDIO4 | - | | |
| W20 | CFG2 | 8 | | |
| V20 | CFG1 | 8 | | |
| V19 | CFG0 | 8 | | |
| V22 | PROGRAMN | 8 | | |
| W22 | CCLK | 8 | | |
| U18 | INITN | 8 | | |
| U22 | DONE | 8 | | |
| GNDIO | GNDIO8 | - | | |
| U20 | WRITEN*** | 8 | | |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|----------------------|------|--------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| U21 | CS1N*** | 8 | | |
| U17 | CSN*** | 8 | | |
| U16 | D0/SPIFASTN*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | |
| T16 | D1*** | 8 | | |
| T17 | D2*** | 8 | | |
| T22 | D3*** | 8 | | |
| GNDIO | GNDIO8 | - | | |
| R22 | D4*** | 8 | | |
| T15 | D5*** | 8 | | |
| R17 | D6*** | 8 | | |
| T20 | D7/SPID0*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | |
| T21 | DI/CSSPI0N*** | 8 | | |
| R21 | DOUT/CSON/CSSPI1N*** | 8 | | |
| R20 | BUSY/SISPI*** | 8 | | |
| R16 | RLM0_PLLCAP | 3 | | |
| R18 | PR65B | 3 | RLM0_GDLLC_FB_A | C |
| GNDIO | GNDIO3 | - | | |
| R19 | PR65A | 3 | RLM0_GDLLT_FB_A | T |
| P22 | PR64B | 3 | RLM0_GDLLC_IN_A** | C (LVDS)* |
| P21 | PR64A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* |
| P16 | PR63B | 3 | RLM0_GPLL_C_IN_A** | C |
| VCCIO | VCCIO3 | 3 | | |
| P17 | PR63A | 3 | RLM0_GPLLT_IN_A** | T |
| P20 | PR62B | 3 | RLM0_GPLL_C_FB_A | C (LVDS)* |
| P19 | PR62A | 3 | RLM0_GPLLT_FB_A | T (LVDS)* |
| GNDIO | GNDIO3 | - | | |
| VCCIO | VCCIO3 | 3 | | |
| P18 | PR55B | 3 | RDQ52 | C |
| N16 | PR55A | 3 | RDQ52 | T |
| GNDIO | GNDIO3 | - | | |
| N22 | PR54B | 3 | RDQ52 | C (LVDS)* |
| N21 | PR54A | 3 | RDQ52 | T (LVDS)* |
| N17 | PR53B | 3 | RDQ52 | C |
| N18 | PR53A | 3 | RDQ52 | T |
| VCCIO | VCCIO3 | 3 | | |
| M22 | PR52B | 3 | RDQ52 | C (LVDS)* |
| M21 | PR52A | 3 | RDQS52 | T (LVDS)* |
| M16 | PR51B | 3 | RDQ52 | C |
| GNDIO | GNDIO3 | - | | |
| M17 | PR51A | 3 | RDQ52 | T |
| M20 | PR50B | 3 | RDQ52 | C (LVDS)* |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| M19 | PR50A | 3 | RDQ52 | T (LVDS)* |
| M18 | PR49B | 3 | RDQ52 | C |
| VCCIO | VCCIO3 | 3 | | |
| L16 | PR49A | 3 | RDQ52 | T |
| L22 | PR48B | 3 | RDQ52 | C (LVDS)* |
| L21 | PR48A | 3 | RDQ52 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | |
| K22 | PR46B | 3 | RLM3_SPLLC_FB_A | C |
| VCCIO | VCCIO3 | 3 | | |
| K21 | PR46A | 3 | RLM3_SPLLT_FB_A | T |
| L17 | PR45B | 3 | RLM3_SPLLC_IN_A | C (LVDS)* |
| L18 | PR45A | 3 | RLM3_SPLLT_IN_A | T (LVDS)* |
| GNDIO | GNDIO3 | - | | |
| L20 | PR44B | 3 | | C |
| L19 | PR44A | 3 | | T |
| K16 | PR43B | 3 | | C (LVDS)* |
| K17 | PR43A | 3 | | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | |
| J16 | PR42B | 3 | VREF2_3 | C |
| K18 | PR42A | 3 | VREF1_3 | T |
| J22 | PR41B | 3 | PCLKC3_0 | C (LVDS)* |
| J21 | PR41A | 3 | PCLKT3_0 | T (LVDS)* |
| H22 | PR39B | 2 | PCLKC2_0/RDQ36 | C |
| H21 | PR39A | 2 | PCLKT2_0/RDQ36 | T |
| GNDIO | GNDIO2 | - | | |
| J17 | PR38B | 2 | RDQ36 | C (LVDS)* |
| J18 | PR38A | 2 | RDQ36 | T (LVDS)* |
| J20 | PR37B | 2 | RDQ36 | C |
| J19 | PR37A | 2 | RDQ36 | T |
| VCCIO | VCCIO2 | 2 | | |
| H16 | PR36B | 2 | RDQ36 | C (LVDS)* |
| H17 | PR36A | 2 | RDQS36 | T (LVDS)* |
| G22 | PR35B | 2 | RDQ36 | C |
| GNDIO | GNDIO2 | - | | |
| G21 | PR35A | 2 | RDQ36 | T |
| H20 | PR34B | 2 | RDQ36 | C (LVDS)* |
| H19 | PR34A | 2 | RDQ36 | T (LVDS)* |
| G16 | PR33B | 2 | RUM3_SPLLC_FB_A/RDQ36 | C |
| VCCIO | VCCIO2 | 2 | | |
| H18 | PR33A | 2 | RUM3_SPLLT_FB_A/RDQ36 | T |
| F22 | PR32B | 2 | RUM3_SPLLC_IN_A/RDQ36 | C (LVDS)* |
| F21 | PR32A | 2 | RUM3_SPLLT_IN_A/RDQ36 | T (LVDS)* |
| G20 | PR30B | 2 | RDQ27 | C |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|-----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| F20 | PR30A | 2 | RDQ27 | T |
| GNDIO | GNDIO2 | - | | |
| G17 | PR29B | 2 | RDQ27 | C (LVDS)* |
| F17 | PR29A | 2 | RDQ27 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | |
| GNDIO | GNDIO2 | - | | |
| E22 | PR14B | 2 | | C |
| D22 | PR14A | 2 | | T |
| VCCIO | VCCIO2 | - | | |
| E20 | PR13B | 2 | | C (LVDS)* |
| D20 | PR13A | 2 | | T (LVDS)* |
| D19 | PR12B | 2 | RUM0_SPLLC_FB_A | C |
| GNDIO | GNDIO2 | - | | |
| E19 | PR12A | 2 | RUM0_SPLLT_FB_A | T |
| F18 | PR11B | 2 | RUM0_SPLLC_IN_A | C (LVDS)* |
| F19 | PR11A | 2 | RUM0_SPLLT_IN_A | T (LVDS)* |
| VCCIO | VCCIO2 | - | | |
| E18 | PR9B | 2 | VREF2_2 | C |
| GNDIO | GNDIO2 | - | | |
| D18 | PR9A | 2 | VREF1_2 | T |
| VCCIO | VCCIO2 | 2 | | |
| F16 | XRES | - | | |
| C22 | URC_SQ_VCCR0 | 12 | | |
| A21 | URC_SQ_HDINP0 | 12 | | T |
| B22 | URC_SQ_VCCIB0 | 12 | | |
| B21 | URC_SQ_HDINN0 | 12 | | C |
| C19 | URC_SQ_VCCTX0 | 12 | | |
| A18 | URC_SQ_HDOUTP0 | 12 | | T |
| A19 | URC_SQ_VCCOB0 | 12 | | |
| B18 | URC_SQ_HDOUTN0 | 12 | | C |
| C18 | URC_SQ_VCCTX1 | 12 | | |
| B17 | URC_SQ_HDOUTN1 | 12 | | C |
| C17 | URC_SQ_VCCOB1 | 12 | | |
| A17 | URC_SQ_HDOUTP1 | 12 | | T |
| C21 | URC_SQ_VCCR1 | 12 | | |
| B20 | URC_SQ_HDINN1 | 12 | | C |
| C20 | URC_SQ_VCCIB1 | 12 | | |
| A20 | URC_SQ_HDINP1 | 12 | | T |
| B16 | URC_SQ_VCCAUX33 | 12 | | |
| E17 | URC_SQ_REFCLKN | 12 | | C |
| D17 | URC_SQ_REFCLKP | 12 | | T |
| C16 | URC_SQ_VCCP | 12 | | |
| A12 | URC_SQ_HDINP2 | 12 | | T |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| C12 | URC_SQ_VCCIB2 | 12 | | |
| B12 | URC_SQ_HDINN2 | 12 | | C |
| C11 | URC_SQ_VCCR2 | 12 | | |
| A15 | URC_SQ_HDOU2 | 12 | | T |
| C15 | URC_SQ_VCCOB2 | 12 | | |
| B15 | URC_SQ_HDOU2N | 12 | | C |
| C14 | URC_SQ_VCCTX2 | 12 | | |
| B14 | URC_SQ_HDOU2N3 | 12 | | C |
| A13 | URC_SQ_VCCOB3 | 12 | | |
| A14 | URC_SQ_HDOU2P3 | 12 | | T |
| C13 | URC_SQ_VCCTX3 | 12 | | |
| B11 | URC_SQ_HDINN3 | 12 | | C |
| B10 | URC_SQ_VCCIB3 | 12 | | |
| A11 | URC_SQ_HDINP3 | 12 | | T |
| C10 | URC_SQ_VCCR3 | 12 | | |
| GNDIO | GNDIO1 | - | | |
| VCCIO | VCCIO1 | 1 | | |
| E13 | PT55B | 1 | | C |
| D12 | PT55A | 1 | | T |
| GNDIO | GNDIO1 | - | | |
| A9 | PT54B | 1 | | C |
| A8 | PT54A | 1 | | T |
| A7 | PT53B | 1 | | C |
| A6 | PT53A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| E12 | PT52B | 1 | | C |
| F12 | PT52A | 1 | | T |
| A5 | PT51B | 1 | | C |
| A4 | PT51A | 1 | | T |
| GNDIO | GNDIO1 | - | | |
| B7 | PT50B | 1 | | C |
| B8 | PT50A | 1 | | T |
| G11 | PT49B | 1 | | C |
| E11 | PT49A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| D11 | PT48B | 1 | VREF2_1 | C |
| D10 | PT48A | 1 | VREF1_1 | T |
| G10 | PT47B | 1 | PCLKC1_0 | C |
| F11 | PT47A | 1 | PCLKT1_0 | T |
| G9 | PT46B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | |
| F9 | PT46A | 0 | PCLKT0_0 | T |
| C9 | PT45B | 0 | VREF2_0 | C |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| D9 | PT45A | 0 | VREF1_0 | T |
| A2 | PT44B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| A3 | PT44A | 0 | | T |
| B3 | PT43B | 0 | | C |
| C4 | PT43A | 0 | | T |
| E10 | PT42B | 0 | | C |
| F10 | PT42A | 0 | | T |
| C7 | PT41B | 0 | | C |
| GNDIO | GNDIO0 | - | | |
| B6 | PT41A | 0 | | T |
| C6 | PT40B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| C5 | PT40A | 0 | | T |
| C8 | PT39B | 0 | | C |
| D8 | PT39A | 0 | | T |
| E8 | PT38B | 0 | | C |
| E9 | PT38A | 0 | | T |
| GNDIO | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | |
| F8 | PT10B | 0 | | C |
| GNDIO | GNDIO0 | - | | |
| G8 | PT10A | 0 | | T |
| F7 | PT9B | 0 | | C |
| G7 | PT9A | 0 | | T |
| C3 | PT8B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| D4 | PT8A | 0 | | T |
| F6 | PT7B | 0 | | C |
| E6 | PT7A | 0 | | T |
| E5 | PT6B | 0 | | C |
| D6 | PT6A | 0 | | T |
| D3 | PT5B | 0 | | C |
| GNDIO | GNDIO0 | - | | |
| E3 | PT5A | 0 | | T |
| D5 | PT4B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| E4 | PT4A | 0 | | T |
| C2 | PT3B | 0 | | C |
| B2 | PT3A | 0 | | T |
| B1 | PT2B | 0 | | C |
| C1 | PT2A | 0 | | T |
| J10 | VCC | - | | |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| J11 | VCC | - | | |
| J12 | VCC | - | | |
| J13 | VCC | - | | |
| K14 | VCC | - | | |
| K9 | VCC | - | | |
| L14 | VCC | - | | |
| L9 | VCC | - | | |
| M14 | VCC | - | | |
| M9 | VCC | - | | |
| N14 | VCC | - | | |
| N9 | VCC | - | | |
| P10 | VCC | - | | |
| P11 | VCC | - | | |
| P12 | VCC | - | | |
| P13 | VCC | - | | |
| B5 | VCCIO0 | 0 | | |
| B9 | VCCIO0 | 0 | | |
| E7 | VCCIO0 | 0 | | |
| H9 | VCCIO0 | 0 | | |
| D13 | VCCIO1 | 1 | | |
| E16 | VCCIO1 | 1 | | |
| H14 | VCCIO1 | 1 | | |
| E21 | VCCIO2 | 2 | | |
| G18 | VCCIO2 | 2 | | |
| J15 | VCCIO2 | 2 | | |
| K19 | VCCIO2 | 2 | | |
| N19 | VCCIO3 | 3 | | |
| P15 | VCCIO3 | 3 | | |
| T18 | VCCIO3 | 3 | | |
| V21 | VCCIO3 | 3 | | |
| AA18 | VCCIO4 | 4 | | |
| R14 | VCCIO4 | 4 | | |
| V16 | VCCIO4 | 4 | | |
| W13 | VCCIO4 | 4 | | |
| AA5 | VCCIO5 | 5 | | |
| R9 | VCCIO5 | 5 | | |
| V7 | VCCIO5 | 5 | | |
| W10 | VCCIO5 | 5 | | |
| N4 | VCCIO6 | 6 | | |
| P8 | VCCIO6 | 6 | | |
| T5 | VCCIO6 | 6 | | |
| V2 | VCCIO6 | 6 | | |
| E2 | VCCIO7 | 7 | | |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| G5 | VCCIO7 | 7 | | |
| J8 | VCCIO7 | 7 | | |
| K4 | VCCIO7 | 7 | | |
| AA22 | VCCIO8 | 8 | | |
| U19 | VCCIO8 | 8 | | |
| H11 | VCCAUX | - | | |
| H12 | VCCAUX | - | | |
| L15 | VCCAUX | - | | |
| L8 | VCCAUX | - | | |
| M15 | VCCAUX | - | | |
| M8 | VCCAUX | - | | |
| R11 | VCCAUX | - | | |
| R12 | VCCAUX | - | | |
| A1 | GND | - | | |
| A10 | GND | - | | |
| A16 | GND | - | | |
| A22 | GND | - | | |
| AA19 | GND | - | | |
| AA4 | GND | - | | |
| AB1 | GND | - | | |
| AB22 | GND | - | | |
| B13 | GND | - | | |
| B19 | GND | - | | |
| B4 | GND | - | | |
| D16 | GND | - | | |
| D2 | GND | - | | |
| D21 | GND | - | | |
| D7 | GND | - | | |
| G19 | GND | - | | |
| G4 | GND | - | | |
| H10 | GND | - | | |
| H13 | GND | - | | |
| J14 | GND | - | | |
| J9 | GND | - | | |
| K10 | GND | - | | |
| K11 | GND | - | | |
| K12 | GND | - | | |
| K13 | GND | - | | |
| K15 | GND | - | | |
| K20 | GND | - | | |
| K3 | GND | - | | |
| K8 | GND | - | | |
| L10 | GND | - | | |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| L11 | GND | - | | |
| L12 | GND | - | | |
| L13 | GND | - | | |
| M10 | GND | - | | |
| M11 | GND | - | | |
| M12 | GND | - | | |
| M13 | GND | - | | |
| N10 | GND | - | | |
| N11 | GND | - | | |
| N12 | GND | - | | |
| N13 | GND | - | | |
| N15 | GND | - | | |
| N20 | GND | - | | |
| N3 | GND | - | | |
| N8 | GND | - | | |
| P14 | GND | - | | |
| P9 | GND | - | | |
| R10 | GND | - | | |
| R13 | GND | - | | |
| T19 | GND | - | | |
| T4 | GND | - | | |
| W16 | GND | - | | |
| W2 | GND | - | | |
| W21 | GND | - | | |
| W7 | GND | - | | |
| Y10 | GND | - | | |
| Y13 | GND | - | | |
| Y15 | NC | - | | |
| W15 | NC | - | | |
| AB20 | NC | - | | |
| AB21 | NC | - | | |
| AA21 | NC | - | | |
| AA20 | NC | - | | |
| AB19 | NC | - | | |
| AB18 | NC | - | | |
| Y22 | NC | - | | |
| Y21 | NC | - | | |
| Y17 | NC | - | | |
| Y18 | NC | - | | |
| Y16 | NC | - | | |
| W17 | NC | - | | |
| Y19 | NC | - | | |
| Y20 | NC | - | | |

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

| LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| W19 | NC | - | | |
| W18 | NC | - | | |
| V17 | NC | - | | |
| V18 | NC | - | | |
| D15 | NC | - | | |
| G14 | NC | - | | |
| G15 | NC | - | | |
| D14 | NC | - | | |
| E15 | NC | - | | |
| E14 | NC | - | | |
| F15 | NC | - | | |
| F14 | NC | - | | |
| F13 | NC | - | | |
| G12 | NC | - | | |
| G13 | NC | - | | |
| H8 | VCCPLL | - | | |
| H15 | VCCPLL | - | | |
| R8 | VCCPLL | - | | |
| R15 | VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| C2 | PL2A | 7 | LDQ6 | T (LVDS)* | PL2A | 7 | LDQ6 | T* |
| C1 | PL2B | 7 | LDQ6 | C (LVDS)* | PL2B | 7 | LDQ6 | C* |
| F6 | PL3A | 7 | LDQ6 | T | PL3A | 7 | LDQ6 | T |
| H9 | PL3B | 7 | LDQ6 | C | PL3B | 7 | LDQ6 | C |
| D3 | PL4A | 7 | LDQ6 | T (LVDS)* | PL4A | 7 | LDQ6 | T* |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| D2 | PL4B | 7 | LDQ6 | C (LVDS)* | PL4B | 7 | LDQ6 | C* |
| F5 | PL5A | 7 | LDQ6 | T | PL5A | 7 | LDQ6 | T |
| H8 | PL5B | 7 | LDQ6 | C | PL5B | 7 | LDQ6 | C |
| E3 | PL6A | 7 | LDQS6 | T (LVDS)* | PL6A | 7 | LDQS6 | T* |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| E2 | PL6B | 7 | LDQ6 | C (LVDS)* | PL6B | 7 | LDQ6 | C* |
| J9 | PL7A | 7 | LDQ6 | T | PL7A | 7 | LDQ6 | T |
| E4 | PL7B | 7 | LDQ6 | C | PL7B | 7 | LDQ6 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| E1 | PL8A | 7 | LDQ6 | T (LVDS)* | PL8A | 7 | LDQ6 | T* |
| D1 | PL8B | 7 | LDQ6 | C (LVDS)* | PL8B | 7 | LDQ6 | C* |
| J8 | PL9A | 7 | VREF2_7/LDQ6 | T | PL9A | 7 | VREF2_7/LDQ6 | T |
| F4 | PL9B | 7 | VREF1_7/LDQ6 | C | PL9B | 7 | VREF1_7/LDQ6 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| - | - | - | | | VCCIO7 | 7 | | |
| F3 | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* | PL11A | 7 | LUM0_SPLLT_IN_A | T* |
| F1 | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C (LVDS)* | PL11B | 7 | LUM0_SPLLC_IN_A | C* |
| G6 | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T | PL12A | 7 | LUM0_SPLLT_FB_A | T |
| K9 | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C | PL12B | 7 | LUM0_SPLLC_FB_A | C |
| - | - | - | | | GNDIO7 | - | | |
| G5 | PL13A | 7 | LDQ15 | T (LVDS)* | PL13A | 7 | | T* |
| VCCIO | VCCIO7 | 7 | | | - | - | | |
| G4 | PL13B | 7 | LDQ15 | C (LVDS)* | PL13B | 7 | | C* |
| H5 | PL14A | 7 | LDQ15 | T | PL14A | 7 | | T |
| - | - | - | | | VCCIO7 | 7 | | |
| H6 | PL14B | 7 | LDQ15 | C | PL14B | 7 | | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| J7 | PL16A | 7 | LDQ15 | T | PL19A | 7 | | T |
| H4 | PL16B | 7 | LDQ15 | C | PL19B | 7 | | C |
| H3 | PL17A | 7 | LDQ15 | T (LVDS)* | PL20A | 7 | | T* |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| G3 | PL17B | 7 | LDQ15 | C (LVDS)* | PL20B | 7 | | C* |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| G1 | PL19A | 7 | LDQ23 | T (LVDS)* | PL23A | 7 | LDQ27 | T* |
| H1 | PL19B | 7 | LDQ23 | C (LVDS)* | PL23B | 7 | LDQ27 | C* |
| J3 | PL20A | 7 | LDQ23 | T | PL24A | 7 | LDQ27 | T |
| J4 | PL20B | 7 | LDQ23 | C | PL24B | 7 | LDQ27 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| H2 | PL21A | 7 | LDQ23 | T (LVDS)* | PL25A | 7 | LDQ27 | T* |
| J2 | PL21B | 7 | LDQ23 | C (LVDS)* | PL25B | 7 | LDQ27 | C* |
| K7 | PL22A | 7 | LDQ23 | T | PL26A | 7 | LDQ27 | T |
| J6 | PL22B | 7 | LDQ23 | C | PL26B | 7 | LDQ27 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| K5 | PL23A | 7 | LDQS23 | T (LVDS)* | PL27A | 7 | LDQS27 | T* | |
| L5 | PL23B | 7 | LDQ23 | C (LVDS)* | PL27B | 7 | LDQ27 | C* | |
| K4 | PL24A | 7 | LDQ23 | T | PL28A | 7 | LDQ27 | T | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| L4 | PL24B | 7 | LDQ23 | C | PL28B | 7 | LDQ27 | C | |
| K3 | PL25A | 7 | LDQ23 | T (LVDS)* | PL29A | 7 | LDQ27 | T* | |
| L3 | PL25B | 7 | LDQ23 | C (LVDS)* | PL29B | 7 | LDQ27 | C* | |
| J1 | PL26A | 7 | LDQ23 | T | PL30A | 7 | LDQ27 | T | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| K2 | PL26B | 7 | LDQ23 | C | PL30B | 7 | LDQ27 | C | |
| K1 | PL28A | 7 | LUM1_SPLLT_IN_A/LDQ32 | T (LVDS)* | PL32A | 7 | LUM3_SPLLT_IN_A/LDQ36 | T* | |
| L1 | PL28B | 7 | LUM1_SPLLC_IN_A/LDQ32 | C (LVDS)* | PL32B | 7 | LUM3_SPLLC_IN_A/LDQ36 | C* | |
| K8 | PL29A | 7 | LUM1_SPLLT_FB_A/LDQ32 | T | PL33A | 7 | LUM3_SPLLT_FB_A/LDQ36 | T | |
| M5 | PL29B | 7 | LUM1_SPLLC_FB_A/LDQ32 | C | PL33B | 7 | LUM3_SPLLC_FB_A/LDQ36 | C | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| M4 | PL30A | 7 | LDQ32 | T (LVDS)* | PL34A | 7 | LDQ36 | T* | |
| M3 | PL30B | 7 | LDQ32 | C (LVDS)* | PL34B | 7 | LDQ36 | C* | |
| L8 | PL31A | 7 | LDQ32 | T | PL35A | 7 | LDQ36 | T | |
| M6 | PL31B | 7 | LDQ32 | C | PL35B | 7 | LDQ36 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| M1 | PL32A | 7 | LDQS32 | T (LVDS)* | PL36A | 7 | LDQS36 | T* | |
| N1 | PL32B | 7 | LDQ32 | C (LVDS)* | PL36B | 7 | LDQ36 | C* | |
| N3 | PL33A | 7 | LDQ32 | T | PL37A | 7 | LDQ36 | T | |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | | |
| N2 | PL33B | 7 | LDQ32 | C | PL37B | 7 | LDQ36 | C | |
| N5 | PL34A | 7 | LDQ32 | T (LVDS)* | PL38A | 7 | LDQ36 | T* | |
| N4 | PL34B | 7 | LDQ32 | C (LVDS)* | PL38B | 7 | LDQ36 | C* | |
| M7 | PL35A | 7 | PCLKT7_0/LDQ32 | T | PL39A | 7 | PCLKT7_0/LDQ36 | T | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| M8 | PL35B | 7 | PCLKC7_0/LDQ32 | C | PL39B | 7 | PCLKC7_0/LDQ36 | C | |
| P3 | PL37A | 6 | PCLKT6_0 | T (LVDS)* | PL41A | 6 | PCLKT6_0 | T* | |
| P2 | PL37B | 6 | PCLKC6_0 | C (LVDS)* | PL41B | 6 | PCLKC6_0 | C* | |
| P5 | PL38A | 6 | VREF2_6 | T | PL42A | 6 | VREF2_6 | T | |
| N6 | PL38B | 6 | VREF1_6 | C | PL42B | 6 | VREF1_6 | C | |
| P4 | PL39A | 6 | | T (LVDS)* | PL43A | 6 | | T* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| R3 | PL39B | 6 | | C (LVDS)* | PL43B | 6 | | C* | |
| P6 | PL40A | 6 | | T | PL44A | 6 | | T | |
| N7 | NC | - | | | PL44B | 6 | | C | |
| P1 | PL41A | 6 | LLM2_SPLLT_IN_A | T (LVDS)* | PL45A | 6 | LLM3_SPLLT_IN_A | T* | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| R1 | PL41B | 6 | LLM2_SPLLC_IN_A | C (LVDS)* | PL45B | 6 | LLM3_SPLLC_IN_A | C* | |
| N8 | PL42A | 6 | LLM2_SPLLT_FB_A | T | PL46A | 6 | LLM3_SPLLT_FB_A | T | |
| R5 | PL42B | 6 | LLM2_SPLLC_FB_A | C | PL46B | 6 | LLM3_SPLLC_FB_A | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| T3 | PL44A | 6 | LDQ48 | T (LVDS)* | PL48A | 6 | LDQ52 | T* | |
| T4 | PL44B | 6 | LDQ48 | C (LVDS)* | PL48B | 6 | LDQ52 | C* | |
| P8 | PL45A | 6 | LDQ48 | T | PL49A | 6 | LDQ52 | T | |
| R6 | PL45B | 6 | LDQ48 | C | PL49B | 6 | LDQ52 | C | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | | |
|-------------|-------------------|------|------------------------------|--------------|-------------------|------|-----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| T1 | PL46A | 6 | LDQ48 | T (LVDS)* | PL50A | 6 | LDQ52 | T* | |
| U1 | PL46B | 6 | LDQ48 | C (LVDS)* | PL50B | 6 | LDQ52 | C* | |
| R7 | PL47A | 6 | LDQ48 | T | PL51A | 6 | LDQ52 | T | |
| T5 | PL47B | 6 | LDQ48 | C | PL51B | 6 | LDQ52 | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| U3 | PL48A | 6 | LDQS48 | T (LVDS)* | PL52A | 6 | LDQS52 | T* | |
| U4 | PL48B | 6 | LDQ48 | C (LVDS)* | PL52B | 6 | LDQ52 | C* | |
| U5 | PL49A | 6 | LDQ48 | T | PL53A | 6 | LDQ52 | T | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| U6 | PL49B | 6 | LDQ48 | C | PL53B | 6 | LDQ52 | C | |
| U2 | PL50A | 6 | LDQ48 | T (LVDS)* | PL54A | 6 | LDQ52 | T* | |
| V1 | PL50B | 6 | LDQ48 | C (LVDS)* | PL54B | 6 | LDQ52 | C* | |
| W2 | PL51A | 6 | LDQ48 | T | PL55A | 6 | LDQ52 | T | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| V2 | PL51B | 6 | LDQ48 | C | PL55B | 6 | LDQ52 | C | |
| V4 | PL55A | 6 | LDQ57 | T (LVDS)* | PL59A | 6 | | T* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| V3 | PL55B | 6 | LDQ57 | C (LVDS)* | PL59B | 6 | | C* | |
| - | - | - | | | GNDIO6 | - | | | |
| W4 | PL57A | 6 | LLM0_GPLLT_IN_A**/LDQS57**** | T (LVDS)* | PL62A | 6 | LLM0_GPLLT_IN_A | T* | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| W3 | PL57B | 6 | LLM0_GPLLC_IN_A**/LDQ57 | C (LVDS)* | PL62B | 6 | LLM0_GPLLC_IN_A | C* | |
| W1 | PL58A | 6 | LLM0_GPLLT_FB_A/LDQ57 | T | PL63A | 6 | LLM0_GPLLT_FB_A | T | |
| Y1 | PL58B | 6 | LLM0_GPLLC_FB_A/LDQ57 | C | PL63B | 6 | LLM0_GPLLC_FB_A | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| AA1 | PL59A | 6 | LLM0_GDLLT_IN_A**/LDQ57 | T (LVDS)* | PL64A | 6 | LLM0_GDLLT_IN_A | T* | |
| AB1 | PL59B | 6 | LLM0_GDLLC_IN_A**/LDQ57 | C (LVDS)* | PL64B | 6 | LLM0_GDLLC_IN_A | C* | |
| U7 | PL60A | 6 | LLM0_GDLLT_FB_A/LDQ57 | T | PL65A | 6 | LLM0_GDLLT_FB_A | T | |
| V6 | PL60B | 6 | LLM0_GDLLC_FB_A/LDQ57 | C | PL65B | 6 | LLM0_GDLLC_FB_A | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| T8 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | | |
| W5 | PL62A | 6 | LDQ66 | T (LVDS)* | PL67A | 6 | LDQ71 | T* | |
| Y4 | PL62B | 6 | LDQ66 | C (LVDS)* | PL67B | 6 | LDQ71 | C* | |
| U8 | PL63A | 6 | LDQ66 | T | PL68A | 6 | LDQ71 | T | |
| W6 | PL63B | 6 | LDQ66 | C | PL68B | 6 | LDQ71 | C | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| Y3 | PL64A | 6 | LDQ66 | T (LVDS)* | PL69A | 6 | LDQ71 | T* | |
| AA3 | PL64B | 6 | LDQ66 | C (LVDS)* | PL69B | 6 | LDQ71 | C* | |
| V7 | NC | - | | | PL70A | 6 | LDQ71 | T | |
| Y5 | PL65B | 6 | LDQ66 | C | PL70B | 6 | LDQ71 | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| AB2 | PL66A | 6 | LDQS66 | T (LVDS)* | PL71A | 6 | LDQS71 | T* | |
| AA4 | PL66B | 6 | LDQ66 | C (LVDS)* | PL71B | 6 | LDQ71 | C* | |
| Y6 | PL67A | 6 | LDQ66 | T | PL72A | 6 | LDQ71 | T | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| U9 | PL67B | 6 | LDQ66 | C | PL72B | 6 | LDQ71 | C | |
| AA5 | PL68A | 6 | LDQ66 | T (LVDS)* | PL73A | 6 | LDQ71 | T* | |
| AA6 | PL68B | 6 | LDQ66 | C (LVDS)* | PL73B | 6 | LDQ71 | C* | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| Y7 | PL69A | 6 | LDQ66 | T | PL74A | 6 | LDQ71 | T | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| V9 | PL69B | 6 | LDQ66 | C | PL74B | 6 | LDQ71 | C | |
| AC3 | TCK | - | | | TCK | - | | | |
| W8 | TDI | - | | | TDI | - | | | |
| AC4 | TMS | - | | | TMS | - | | | |
| V8 | TDO | - | | | TDO | - | | | |
| AA7 | VCCJ | - | | | VCCJ | - | | | |
| AB6 | PB2A | 5 | BDQ6 | T | PB2A | 5 | BDQ6 | T | |
| Y8 | PB2B | 5 | BDQ6 | C | PB2B | 5 | BDQ6 | C | |
| AD1 | PB3A | 5 | BDQ6 | T | PB3A | 5 | BDQ6 | T | |
| AD2 | PB3B | 5 | BDQ6 | C | PB3B | 5 | BDQ6 | C | |
| AC5 | PB4A | 5 | BDQ6 | T | PB4A | 5 | BDQ6 | T | |
| AA8 | PB4B | 5 | BDQ6 | C | PB4B | 5 | BDQ6 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AC6 | PB5A | 5 | BDQ6 | T | PB5A | 5 | BDQ6 | T | |
| W9 | PB5B | 5 | BDQ6 | C | PB5B | 5 | BDQ6 | C | |
| AB7 | PB6A | 5 | BDQS6 | T | PB6A | 5 | BDQS6 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| Y9 | PB6B | 5 | BDQ6 | C | PB6B | 5 | BDQ6 | C | |
| AD3 | PB7A | 5 | BDQ6 | T | PB7A | 5 | BDQ6 | T | |
| AD4 | PB7B | 5 | BDQ6 | C | PB7B | 5 | BDQ6 | C | |
| AA9 | PB8A | 5 | BDQ6 | T | PB8A | 5 | BDQ6 | T | |
| W10 | PB8B | 5 | BDQ6 | C | PB8B | 5 | BDQ6 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AC7 | PB9A | 5 | BDQ6 | T | PB9A | 5 | BDQ6 | T | |
| Y10 | PB9B | 5 | BDQ6 | C | PB9B | 5 | BDQ6 | C | |
| AE2 | PB10A | 5 | BDQ6 | T | PB10A | 5 | BDQ6 | T | |
| AD5 | PB10B | 5 | BDQ6 | C | PB10B | 5 | BDQ6 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AE4 | PB11A | 5 | BDQ15 | T | PB11A | 5 | BDQ15 | T | |
| AE3 | PB11B | 5 | BDQ15 | C | PB11B | 5 | BDQ15 | C | |
| W11 | PB12A | 5 | BDQ15 | T | PB12A | 5 | BDQ15 | T | |
| AB8 | PB12B | 5 | BDQ15 | C | PB12B | 5 | BDQ15 | C | |
| AE5 | PB13A | 5 | BDQ15 | T | PB13A | 5 | BDQ15 | T | |
| AD6 | PB13B | 5 | BDQ15 | C | PB13B | 5 | BDQ15 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AA10 | PB14A | 5 | BDQ15 | T | PB14A | 5 | BDQ15 | T | |
| AC8 | PB14B | 5 | BDQ15 | C | PB14B | 5 | BDQ15 | C | |
| W12 | PB15A | 5 | BDQS15 | T | PB15A | 5 | BDQS15 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AC9 | PB15B | 5 | BDQ15 | C | PB15B | 5 | BDQ15 | C | |
| W13 | PB16A | 5 | BDQ15 | T | PB16A | 5 | BDQ15 | T | |
| AB10 | PB16B | 5 | BDQ15 | C | PB16B | 5 | BDQ15 | C | |
| AF3 | PB17A | 5 | BDQ15 | T | PB17A | 5 | BDQ15 | T | |
| AF4 | PB17B | 5 | BDQ15 | C | PB17B | 5 | BDQ15 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AF5 | PB18A | 5 | BDQ15 | T | PB18A | 5 | BDQ15 | T | |
| AF6 | PB18B | 5 | BDQ15 | C | PB18B | 5 | BDQ15 | C | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| Y12 | PB19A | 5 | BDQ15 | T | PB19A | 5 | BDQ15 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AB11 | PB19B | 5 | BDQ15 | C | PB19B | 5 | BDQ15 | C | |
| - | - | - | | | VCCIO5 | 5 | | | |
| - | - | - | | | GNDIO5 | - | | | |
| AD7 | PB20A | 5 | BDQ24 | T | PB29A | 5 | BDQ33 | T | |
| AF7 | PB20B | 5 | BDQ24 | C | PB29B | 5 | BDQ33 | C | |
| AD8 | PB21A | 5 | BDQ24 | T | PB30A | 5 | BDQ33 | T | |
| AA12 | PB21B | 5 | BDQ24 | C | PB30B | 5 | BDQ33 | C | |
| AE8 | PB22A | 5 | BDQ24 | T | PB31A | 5 | BDQ33 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AF8 | PB22B | 5 | BDQ24 | C | PB31B | 5 | BDQ33 | C | |
| AD9 | PB23A | 5 | BDQ24 | T | PB32A | 5 | BDQ33 | T | |
| AC10 | PB23B | 5 | BDQ24 | C | PB32B | 5 | BDQ33 | C | |
| AC11 | PB24A | 5 | BDQS24 | T | PB33A | 5 | BDQS33 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AB12 | PB24B | 5 | BDQ24 | C | PB33B | 5 | BDQ33 | C | |
| AD10 | PB25A | 5 | BDQ24 | T | PB34A | 5 | BDQ33 | T | |
| Y13 | PB25B | 5 | BDQ24 | C | PB34B | 5 | BDQ33 | C | |
| AF9 | PB26A | 5 | BDQ24 | T | PB35A | 5 | BDQ33 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AE9 | PB26B | 5 | BDQ24 | C | PB35B | 5 | BDQ33 | C | |
| AF10 | PB27A | 5 | BDQ24 | T | PB36A | 5 | BDQ33 | T | |
| AE10 | PB27B | 5 | BDQ24 | C | PB36B | 5 | BDQ33 | C | |
| AD11 | PB28A | 5 | BDQ24 | T | PB37A | 5 | BDQ33 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AF11 | PB28B | 5 | BDQ24 | C | PB37B | 5 | BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AA13 | PB33A | 5 | BDQS33**** | T | PB42A | 5 | BDQS42**** | T | |
| AB13 | PB33B | 5 | BDQ33 | C | PB42B | 5 | BDQ42 | C | |
| W14 | PB34A | 5 | VREF2_5/BDQ33 | T | PB43A | 5 | VREF2_5/BDQ42 | T | |
| AC12 | PB34B | 5 | VREF1_5/BDQ33 | C | PB43B | 5 | VREF1_5/BDQ42 | C | |
| AF12 | PB35A | 5 | PCLKT5_0/BDQ33 | T | PB44A | 5 | PCLKT5_0/BDQ42 | T | |
| AD12 | PB35B | 5 | PCLKC5_0/BDQ33 | C | PB44B | 5 | PCLKC5_0/BDQ42 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AC13 | PB40A | 4 | PCLKT4_0/BDQ42 | T | PB49A | 4 | PCLKT4_0/BDQ51 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| Y14 | PB40B | 4 | PCLKC4_0/BDQ42 | C | PB49B | 4 | PCLKC4_0/BDQ51 | C | |
| AB20 | PB57A | 4 | BDQ60 | T | PB50A | 4 | VREF2_4/BDQ51 | T | |
| AC14 | PB41B | 4 | VREF1_4/BDQ42 | C | PB50B | 4 | VREF1_4/BDQ51 | C | |
| AB14 | PB42A | 4 | BDQS42**** | T | PB51A | 4 | BDQS51**** | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA14 | PB42B | 4 | BDQ42 | C | PB51B | 4 | BDQ51 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| W17 | PB65A | 4 | BDQ69 | T | PB56A | 4 | BDQ60 | T | |
| AA19 | PB65B | 4 | BDQ69 | C | PB56B | 4 | BDQ60 | C | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AC15 | PB48A | 4 | BDQ51 | T | PB57A | 4 | BDQ60 | T | |
| Y18 | PB68B | 4 | BDQ69 | C | PB57B | 4 | BDQ60 | C | |
| AB15 | PB49A | 4 | BDQ51 | T | PB58A | 4 | BDQ60 | T | |
| AC16 | PB49B | 4 | BDQ51 | C | PB58B | 4 | BDQ60 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AA17 | PB60A | 4 | BDQS60**** | T | PB59A | 4 | BDQ60 | T | |
| AB16 | PB50B | 4 | BDQ51 | C | PB59B | 4 | BDQ60 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AA15 | PB51A | 4 | BDQS51**** | T | PB60A | 4 | BDQS60 | T | |
| W16 | PB59B | 4 | BDQ60 | C | PB60B | 4 | BDQ60 | C | |
| Y15 | PB52A | 4 | BDQ51 | T | PB61A | 4 | BDQ60 | T | |
| AC17 | PB52B | 4 | BDQ51 | C | PB61B | 4 | BDQ60 | C | |
| AA18 | PB61A | 4 | BDQ60 | T | PB62A | 4 | BDQ60 | T | |
| Y17 | PB61B | 4 | BDQ60 | C | PB62B | 4 | BDQ60 | C | |
| - | - | - | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | - | - | | | |
| W15 | PB54A | 4 | BDQ51 | T | PB63A | 4 | BDQ60 | T | |
| AB17 | PB54B | 4 | BDQ51 | C | PB63B | 4 | BDQ60 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| V17 | PB73A | 4 | BDQ69 | T | PB72A | 4 | BDQ69 | T | |
| AA20 | PB73B | 4 | BDQ69 | C | PB72B | 4 | BDQ69 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AD13 | VCC | - | | | LRC_SQ_VCCRX3 | 13 | | | |
| AF14 | PB47A | 4 | BDQ51 | T | LRC_SQ_HDINP3 | 13 | | T | |
| AE13 | NC | - | | | LRC_SQ_VCCIB3 | 13 | | | |
| AE14 | PB41A | 4 | VREF2_4/BDQ42 | T | LRC_SQ_HDINN3 | 13 | | C | |
| AD16 | VCC | - | | | LRC_SQ_VCCTX3 | 13 | | | |
| AF17 | PB51B | 4 | BDQ51 | C | LRC_SQ_HDOUTP3 | 13 | | T | |
| AF16 | NC | - | | | LRC_SQ_VCCOB3 | 13 | | | |
| AE17 | PB50A | 4 | BDQ51 | T | LRC_SQ_HDOUTN3 | 13 | | C | |
| AD17 | VCC | - | | | LRC_SQ_VCCTX2 | 13 | | | |
| AE18 | PB53B | 4 | BDQ51 | C | LRC_SQ_HDOUTN2 | 13 | | C | |
| AD18 | NC | - | | | LRC_SQ_VCCOB2 | 13 | | | |
| AF18 | PB53A | 4 | BDQ51 | T | LRC_SQ_HDOUTP2 | 13 | | T | |
| AD14 | VCC | - | | | LRC_SQ_VCCRX2 | 13 | | | |
| AE15 | PB48B | 4 | BDQ51 | C | LRC_SQ_HDINN2 | 13 | | C | |
| AD15 | NC | - | | | LRC_SQ_VCCIB2 | 13 | | | |
| AF15 | PB47B | 4 | BDQ51 | C | LRC_SQ_HDINP2 | 13 | | T | |
| AD19 | VCC | - | | | LRC_SQ_VCCP | 13 | | | |
| AC19 | PB57B | 4 | BDQ60 | C | LRC_SQ_REFCLKP | 13 | | T | |
| AB19 | PB59A | 4 | BDQ60 | T | LRC_SQ_REFCLKN | 13 | | C | |
| AE19 | VCCAUX | - | | | LRC_SQ_VCCAUX33 | 13 | | | |
| AF23 | PB64A | 4 | BDQ60 | T | LRC_SQ_HDINP1 | 13 | | T | |
| AD23 | NC | - | | | LRC_SQ_VCCIB1 | 13 | | | |
| AE23 | PB66B | 4 | BDQ69 | C | LRC_SQ_HDINN1 | 13 | | C | |
| AD24 | VCC | - | | | LRC_SQ_VCCRX1 | 13 | | | |
| AF20 | PB55A | 4 | BDQ51 | T | LRC_SQ_HDOUTP1 | 13 | | T | |
| AD20 | NC | - | | | LRC_SQ_VCCOB1 | 13 | | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|-------------------------|--------------|--------------------------|------|-----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AE20 | PB55B | 4 | BDQ51 | C | LRC_SQ_HDOUTN1 | 13 | | C |
| AD21 | VCC | - | | | LRC_SQ_VCCTX1 | 13 | | |
| AE21 | PB63B | 4 | BDQ60 | C | LRC_SQ_HDOUTN0 | 13 | | C |
| AF22 | NC | - | | | LRC_SQ_VCCOB0 | 13 | | |
| AF21 | PB62A | 4 | BDQ60 | T | LRC_SQ_HDOUTP0 | 13 | | T |
| AD22 | VCC | - | | | LRC_SQ_VCCTX0 | 13 | | |
| AE24 | PB67B | 4 | BDQ69 | C | LRC_SQ_HDINN0 | 13 | | C |
| AE25 | NC | - | | | LRC_SQ_VCCIB0 | 13 | | |
| AF24 | PB67A | 4 | BDQ69 | T | LRC_SQ_HDINP0 | 13 | | T |
| AD25 | VCC | - | | | LRC_SQ_VCCR0 | 13 | | |
| AA21 | CFG2 | 8 | | | CFG2 | 8 | | |
| AA22 | CFG1 | 8 | | | CFG1 | 8 | | |
| AB23 | CFG0 | 8 | | | CFG0 | 8 | | |
| AC26 | PROGRAMN | 8 | | | PROGRAMN | 8 | | |
| AB24 | CCLK | 8 | | | CCLK | 8 | | |
| AA23 | INITN | 8 | | | INITN | 8 | | |
| AB25 | DONE | 8 | | | DONE | 8 | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| Y19 | PR68B | 8 | WRITEN*** | C | WRITEN*** | 8 | | |
| Y21 | PR68A | 8 | CS1N*** | T | CS1N*** | 8 | | |
| AB26 | PR67B | 8 | CSN*** | C | CSN*** | 8 | | |
| Y22 | PR67A | 8 | D0/SPIFASTN*** | T | D0/SPIFASTN*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | | | 8 | | |
| W19 | PR66B | 8 | D1*** | C | D1*** | 8 | | |
| Y20 | PR66A | 8 | D2*** | T | D2*** | 8 | | |
| W22 | PR65B | 8 | D3*** | C | D3*** | 8 | | |
| GNDIO | GNDIO8 | - | | | | - | | |
| W18 | PR65A | 8 | D4*** | T | D4*** | 8 | | |
| Y23 | PR64B | 8 | D5*** | C | D5*** | 8 | | |
| AA24 | PR64A | 8 | D6*** | T | D6*** | 8 | | |
| W21 | PR63B | 8 | D7/SPID0*** | C | D7/SPID0*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| V20 | PR63A | 8 | DI/CSSPI0N*** | T | DI/CSSPI0N*** | 8 | | |
| W23 | PR62B | 8 | DOUT/CSON/CSSPI1N*** | C | DOUT/CSON/ CSSPI1N*** | 8 | | |
| Y24 | PR62A | 8 | BUSY/SISPI*** | T | BUSY/SISPI*** | 8 | | |
| V19 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| V21 | PR60B | 3 | RLM0_GDLLC_FB_A | C | PR65B | 3 | RLM0_GDLLC_FB_A | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| U19 | PR60A | 3 | RLM0_GDLLT_FB_A/RDQ57 | T | PR65A | 3 | RLM0_GDLLT_FB_A | T |
| AA26 | PR59B | 3 | RLM0_GDLLC_IN_A**/RDQ57 | C (LVDS)* | PR64B | 3 | RLM0_GDLLC_IN_A | C* |
| Y26 | PR59A | 3 | RLM0_GDLLT_IN_A**/RDQ57 | T (LVDS)* | PR64A | 3 | RLM0_GDLLT_IN_A | T* |
| V23 | PR58B | 3 | RLM0_GPLLC_IN_A**/RDQ57 | C | PR63B | 3 | RLM0_GPLLC_IN_A | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| U20 | PR58A | 3 | RLM0_GPLLT_IN_A**/RDQ57 | T | PR63A | 3 | RLM0_GPLLT_IN_A | T |
| W24 | PR57B | 3 | RLM0_GPLLC_FB_A/RDQ57 | C (LVDS)* | PR62B | 3 | RLM0_GPLLC_FB_A | C* |
| V24 | PR57A | 3 | RLM0_GPLLT_FB_A/RDQ57 | T (LVDS)* | PR62A | 3 | RLM0_GPLLT_FB_A | T* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| U21 | PR56A | 3 | RDQ57 | T | PR60A | 3 | | T |
| W25 | PR55B | 3 | RDQ57 | C (LVDS)* | PR59B | 3 | | C* |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| W26 | PR55A | 3 | RDQ57 | T (LVDS)* | PR59A | 3 | | T* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| U18 | PR54B | 3 | RDQ57 | C | PR58B | 3 | | C |
| U22 | PR54A | 3 | RDQ57 | T | PR58A | 3 | | T |
| V25 | PR53B | 3 | RDQ57 | C (LVDS)* | PR57B | 3 | | C* |
| V26 | PR53A | 3 | RDQ57 | T (LVDS)* | PR57A | 3 | | T* |
| U24 | PR51B | 3 | RDQ48 | C | PR55B | 3 | RDQ52 | C |
| T24 | PR51A | 3 | RDQ48 | T | PR55A | 3 | RDQ52 | T |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| T22 | PR50B | 3 | RDQ48 | C (LVDS)* | PR54B | 3 | RDQ52 | C* |
| T23 | PR50A | 3 | RDQ48 | T (LVDS)* | PR54A | 3 | RDQ52 | T* |
| U25 | PR49B | 3 | RDQ48 | C | PR53B | 3 | RDQ52 | C |
| U26 | PR49A | 3 | RDQ48 | T | PR53A | 3 | RDQ52 | T |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| T19 | PR48B | 3 | RDQ48 | C (LVDS)* | PR52B | 3 | RDQ52 | C* |
| R19 | PR48A | 3 | RDQS48 | T (LVDS)* | PR52A | 3 | RDQS52 | T* |
| R21 | PR47B | 3 | RDQ48 | C | PR51B | 3 | RDQ52 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| R20 | PR47A | 3 | RDQ48 | T | PR51A | 3 | RDQ52 | T |
| T26 | PR46B | 3 | RDQ48 | C (LVDS)* | PR50B | 3 | RDQ52 | C* |
| R26 | PR46A | 3 | RDQ48 | T (LVDS)* | PR50A | 3 | RDQ52 | T* |
| P21 | PR45B | 3 | RDQ48 | C | PR49B | 3 | RDQ52 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| P19 | PR45A | 3 | RDQ48 | T | PR49A | 3 | RDQ52 | T |
| R23 | PR44B | 3 | RDQ48 | C (LVDS)* | PR48B | 3 | RDQ52 | C* |
| R24 | PR44A | 3 | RDQ48 | T (LVDS)* | PR48A | 3 | RDQ52 | T* |
| - | - | - | | | GNDIO3 | - | | |
| R22 | PR42B | 3 | RLM2_SPLLC_FB_A | C | PR46B | 3 | RLM3_SPLLC_FB_A | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| N19 | PR42A | 3 | RLM2_SPLLT_FB_A | T | PR46A | 3 | RLM3_SPLLT_FB_A | T |
| P23 | PR41B | 3 | RLM2_SPLLC_IN_A | C (LVDS)* | PR45B | 3 | RLM3_SPLLC_IN_A | C* |
| P24 | PR41A | 3 | RLM2_SPLLT_IN_A | T (LVDS)* | PR45A | 3 | RLM3_SPLLT_IN_A | T* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| N21 | PR40B | 3 | | C | PR44B | 3 | | C |
| P22 | PR40A | 3 | | T | PR44A | 3 | | T |
| N20 | PR39B | 3 | | C (LVDS)* | PR43B | 3 | | C* |
| N22 | PR39A | 3 | | T (LVDS)* | PR43A | 3 | | T* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| P25 | PR38B | 3 | VREF2_3 | C | PR42B | 3 | VREF2_3 | C |
| P26 | PR38A | 3 | VREF1_3 | T | PR42A | 3 | VREF1_3 | T |
| M21 | PR37B | 3 | PCLKC3_0 | C (LVDS)* | PR41B | 3 | PCLKC3_0 | C* |
| N23 | PR37A | 3 | PCLKT3_0 | T (LVDS)* | PR41A | 3 | PCLKT3_0 | T* |
| N24 | PR35B | 2 | PCLKC2_0/RDQ32 | C | PR39B | 2 | PCLKC2_0/RDQ36 | C |
| N25 | PR35A | 2 | PCLKT2_0/RDQ32 | T | PR39A | 2 | PCLKT2_0/RDQ36 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| M22 | PR34B | 2 | RDQ32 | C (LVDS)* | PR38B | 2 | RDQ36 | C* |
| M24 | PR34A | 2 | RDQ32 | T (LVDS)* | PR38A | 2 | RDQ36 | T* |
| M23 | PR33B | 2 | RDQ32 | C | PR37B | 2 | RDQ36 | C |
| N26 | PR33A | 2 | RDQ32 | T | PR37A | 2 | RDQ36 | T |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L22 | PR32B | 2 | RDQ32 | C (LVDS)* | PR36B | 2 | RDQ36 | C* |
| L24 | PR32A | 2 | RDQS32 | T (LVDS)* | PR36A | 2 | RDQS36 | T* |
| L23 | PR31B | 2 | RDQ32 | C | PR35B | 2 | RDQ36 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| M20 | PR31A | 2 | RDQ32 | T | PR35A | 2 | RDQ36 | T |
| M26 | PR30B | 2 | RDQ32 | C (LVDS)* | PR34B | 2 | RDQ36 | C* |
| L26 | PR30A | 2 | RDQ32 | T (LVDS)* | PR34A | 2 | RDQ36 | T* |
| K22 | PR29B | 2 | RUM1_SPLLC_FB_A/RDQ32 | C | PR33B | 2 | RUM3_SPLLC_FB_A/RDQ36 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M19 | PR29A | 2 | RUM1_SPLLT_FB_A/RDQ32 | T | PR33A | 2 | RUM3_SPLLT_FB_A/RDQ36 | T |
| K25 | PR28B | 2 | RUM1_SPLLC_IN_A/RDQ32 | C (LVDS)* | PR32B | 2 | RUM3_SPLLC_IN_A/RDQ36 | C* |
| K26 | PR28A | 2 | RUM1_SPLLT_IN_A/RDQ32 | T (LVDS)* | PR32A | 2 | RUM3_SPLLT_IN_A/RDQ36 | T* |
| K24 | PR26B | 2 | RDQ23 | C | PR30B | 2 | RDQ27 | C |
| K23 | PR26A | 2 | RDQ23 | T | PR30A | 2 | RDQ27 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| L19 | PR25B | 2 | RDQ23 | C (LVDS)* | PR29B | 2 | RDQ27 | C* |
| K21 | PR25A | 2 | RDQ23 | T (LVDS)* | PR29A | 2 | RDQ27 | T* |
| J23 | PR24B | 2 | RDQ23 | C | PR28B | 2 | RDQ27 | C |
| J24 | PR24A | 2 | RDQ23 | T | PR28A | 2 | RDQ27 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K20 | PR23B | 2 | RDQ23 | C (LVDS)* | PR27B | 2 | RDQ27 | C* |
| J21 | PR23A | 2 | RDQS23 | T (LVDS)* | PR27A | 2 | RDQS27 | T* |
| H21 | PR22B | 2 | RDQ23 | C | PR26B | 2 | RDQ27 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| K18 | PR22A | 2 | RDQ23 | T | PR26A | 2 | RDQ27 | T |
| H22 | PR21B | 2 | RDQ23 | C (LVDS)* | PR25B | 2 | RDQ27 | C* |
| J20 | PR21A | 2 | RDQ23 | T (LVDS)* | PR25A | 2 | RDQ27 | T* |
| J25 | PR20B | 2 | RDQ23 | C | PR24B | 2 | RDQ27 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J26 | PR20A | 2 | RDQ23 | T | PR24A | 2 | RDQ27 | T |
| G21 | PR19B | 2 | RDQ23 | C (LVDS)* | PR23B | 2 | RDQ27 | C* |
| J19 | PR19A | 2 | RDQ23 | T (LVDS)* | PR23A | 2 | RDQ27 | T* |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| H23 | PR18B | 2 | RDQ15 | C | PR21B | 2 | | C |
| H24 | PR18A | 2 | RDQ15 | T | PR21A | 2 | | T |
| H25 | PR17B | 2 | RDQ15 | C (LVDS)* | PR20B | 2 | | C* |
| H26 | PR17A | 2 | RDQ15 | T (LVDS)* | PR20A | 2 | | T* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| G22 | PR16B | 2 | RDQ15 | C | PR19B | 2 | | C |
| K19 | PR16A | 2 | RDQ15 | T | PR19A | 2 | | T |
| G24 | PR15B | 2 | RDQ15 | C (LVDS)* | PR18B | 2 | | C* |
| G23 | PR15A | 2 | RDQS15 | T (LVDS)* | PR18A | 2 | | T* |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| J18 | PR14B | 2 | RDQ15 | C | PR14B | 2 | | C |
| F22 | PR14A | 2 | RDQ15 | T | PR14A | 2 | | T |
| - | - | - | | | VCCIO2 | 2 | | |
| F23 | PR13B | 2 | RDQ15 | C (LVDS)* | PR13B | 2 | | C* |
| F24 | PR13A | 2 | RDQ15 | T (LVDS)* | PR13A | 2 | | T* |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | | |
|-------------|-----------------------------|------|-----------------------|--------------|-----------------------------|------|-----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| VCCIO | VCCIO2 | 2 | | | - | - | | | |
| H20 | PR12B | 2 | RUM0_SPLLC_FB_A/RDQ15 | C | PR12B | 2 | RUM0_SPLLC_FB_A | C | |
| - | - | - | | | GNDIO2 | - | | | |
| F21 | PR12A | 2 | RUM0_SPLLT_FB_A/RDQ15 | T | PR12A | 2 | RUM0_SPLLT_FB_A | T | |
| G26 | PR11B | 2 | RUM0_SPLLC_IN_A/RDQ15 | C (LVDS)* | PR11B | 2 | RUM0_SPLLC_IN_A | C* | |
| F26 | PR11A | 2 | RUM0_SPLLT_IN_A/RDQ15 | T (LVDS)* | PR11A | 2 | RUM0_SPLLT_IN_A | T* | |
| - | - | - | | | VCCIO2 | 2 | | | |
| E24 | PR9B | 2 | VREF2_2 | C | PR9B | 2 | VREF2_2 | C | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| E23 | PR9A | 2 | VREF1_2 | T | PR9A | 2 | VREF1_2 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO2 | 2 | | | |
| H19 | XRES | - | | | XRES | - | | | |
| C25 | URC_SQ_VCCR _{X0} | 12 | | | URC_SQ_VCCR _{X0} | 12 | | | |
| A24 | URC_SQ_HDIN _{P0} | 12 | | T | URC_SQ_HDIN _{P0} | 12 | | T | |
| B25 | URC_SQ_VCCIB ₀ | 12 | | | URC_SQ_VCCIB ₀ | 12 | | | |
| B24 | URC_SQ_HDINN ₀ | 12 | | C | URC_SQ_HDINN ₀ | 12 | | C | |
| C22 | URC_SQ_VCCT _{X0} | 12 | | | URC_SQ_VCCT _{X0} | 12 | | | |
| A21 | URC_SQ_HDOUT _{P0} | 12 | | T | URC_SQ_HDOUT _{P0} | 12 | | T | |
| A22 | URC_SQ_VCCOB ₀ | 12 | | | URC_SQ_VCCOB ₀ | 12 | | | |
| B21 | URC_SQ_HDOUT _{N0} | 12 | | C | URC_SQ_HDOUT _{N0} | 12 | | C | |
| C21 | URC_SQ_VCCT _{X1} | 12 | | | URC_SQ_VCCT _{X1} | 12 | | | |
| B20 | URC_SQ_HDOUT _{N1} | 12 | | C | URC_SQ_HDOUT _{N1} | 12 | | C | |
| C20 | URC_SQ_VCCOB ₁ | 12 | | | URC_SQ_VCCOB ₁ | 12 | | | |
| A20 | URC_SQ_HDOUT _{P1} | 12 | | T | URC_SQ_HDOUT _{P1} | 12 | | T | |
| C24 | URC_SQ_VCCR _{X1} | 12 | | | URC_SQ_VCCR _{X1} | 12 | | | |
| B23 | URC_SQ_HDINN ₁ | 12 | | C | URC_SQ_HDINN ₁ | 12 | | C | |
| C23 | URC_SQ_VCCIB ₁ | 12 | | | URC_SQ_VCCIB ₁ | 12 | | | |
| A23 | URC_SQ_HDIN _{P1} | 12 | | T | URC_SQ_HDIN _{P1} | 12 | | T | |
| B19 | URC_SQ_VCCAUX ₃₃ | 12 | | | URC_SQ_VCCAUX ₃₃ | 12 | | | |
| E19 | URC_SQ_REFCLK _N | 12 | | C | URC_SQ_REFCLK _N | 12 | | C | |
| D19 | URC_SQ_REFCLK _P | 12 | | T | URC_SQ_REFCLK _P | 12 | | T | |
| C19 | URC_SQ_VCCP | 12 | | | URC_SQ_VCCP | 12 | | | |
| A15 | URC_SQ_HDIN _{P2} | 12 | | T | URC_SQ_HDIN _{P2} | 12 | | T | |
| C15 | URC_SQ_VCCIB ₂ | 12 | | | URC_SQ_VCCIB ₂ | 12 | | | |
| B15 | URC_SQ_HDINN ₂ | 12 | | C | URC_SQ_HDINN ₂ | 12 | | C | |
| C14 | URC_SQ_VCCR _{X2} | 12 | | | URC_SQ_VCCR _{X2} | 12 | | | |
| A18 | URC_SQ_HDOUT _{P2} | 12 | | T | URC_SQ_HDOUT _{P2} | 12 | | T | |
| C18 | URC_SQ_VCCOB ₂ | 12 | | | URC_SQ_VCCOB ₂ | 12 | | | |
| B18 | URC_SQ_HDOUT _{N2} | 12 | | C | URC_SQ_HDOUT _{N2} | 12 | | C | |
| C17 | URC_SQ_VCCT _{X2} | 12 | | | URC_SQ_VCCT _{X2} | 12 | | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| B17 | URC_SQ_HDOU N3 | 12 | | C | URC_SQ_HDOU N3 | 12 | | C |
| A16 | URC_SQ_VCCO B3 | 12 | | | URC_SQ_VCCO B3 | 12 | | |
| A17 | URC_SQ_HDOU P3 | 12 | | T | URC_SQ_HDOU P3 | 12 | | T |
| C16 | URC_SQ_VCCT X3 | 12 | | | URC_SQ_VCCT X3 | 12 | | |
| B14 | URC_SQ_HDINN 3 | 12 | | C | URC_SQ_HDINN 3 | 12 | | C |
| B13 | URC_SQ_VCCIB 3 | 12 | | | URC_SQ_VCCIB 3 | 12 | | |
| A14 | URC_SQ_HDIN P3 | 12 | | T | URC_SQ_HDIN P3 | 12 | | T |
| C13 | URC_SQ_VCCR X3 | 12 | | | URC_SQ_VCCR X3 | 12 | | |
| - | - | - | | | GNDIO1 | - | | |
| - | - | - | | | VCCIO1 | 1 | | |
| E17 | PT46B | 1 | | C | PT55B | 1 | | C |
| D17 | PT46A | 1 | | T | PT55A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| F17 | PT45B | 1 | | C | PT54B | 1 | | C |
| D16 | PT45A | 1 | | T | PT54A | 1 | | T |
| F19 | PT44B | 1 | | C | PT53B | 1 | | C |
| F18 | PT44A | 1 | | T | PT53A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E16 | PT43B | 1 | | C | PT52B | 1 | | C |
| D15 | PT43A | 1 | | T | PT52A | 1 | | T |
| G18 | PT42B | 1 | | C | PT51B | 1 | | C |
| E15 | PT42A | 1 | | T | PT51A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| G17 | PT41B | 1 | | C | PT50B | 1 | | C |
| E14 | PT41A | 1 | | T | PT50A | 1 | | T |
| D14 | PT40B | 1 | | C | PT49B | 1 | | C |
| D13 | PT40A | 1 | | T | PT49A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F15 | PT39B | 1 | VREF2_1 | C | PT48B | 1 | VREF2_1 | C |
| E12 | PT39A | 1 | VREF1_1 | T | PT48A | 1 | VREF1_1 | T |
| H17 | PT38B | 1 | PCLKC1_0 | C | PT47B | 1 | PCLKC1_0 | C |
| E13 | PT38A | 1 | PCLKT1_0 | T | PT47A | 1 | PCLKT1_0 | T |
| C12 | PT37B | 0 | PCLKC0_0 | C | PT46B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| G15 | PT37A | 0 | PCLKT0_0 | T | PT46A | 0 | PCLKT0_0 | T |
| C11 | PT36B | 0 | VREF2_0 | C | PT45B | 0 | VREF2_0 | C |
| F14 | PT36A | 0 | VREF1_0 | T | PT45A | 0 | VREF1_0 | T |
| A12 | PT35B | 0 | | C | PT44B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| A11 | PT35A | 0 | | T | PT44A | 0 | | T |
| D12 | PT34B | 0 | | C | PT43B | 0 | | C |
| H16 | PT34A | 0 | | T | PT43A | 0 | | T |
| H18 | PT33B | 0 | | C | PT42B | 0 | | C |
| H15 | PT33A | 0 | | T | PT42A | 0 | | T |
| A10 | PT32B | 0 | | C | PT41B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| B10 | PT32A | 0 | | T | PT41A | 0 | | T |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D11 | PT31B | 0 | | C | PT40B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| G14 | PT31A | 0 | | T | PT40A | 0 | | T |
| E11 | PT30B | 0 | | C | PT39B | 0 | | C |
| F13 | PT30A | 0 | | T | PT39A | 0 | | T |
| D10 | PT29B | 0 | | C | PT38B | 0 | | C |
| H14 | PT29A | 0 | | T | PT38A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| A9 | PT24B | 0 | | C | PT24B | 0 | | C |
| C10 | PT23B | 0 | | C | PT23B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| E8 | PT23A | 0 | | T | PT23A | 0 | | T |
| B9 | PT22B | 0 | | C | PT22B | 0 | | C |
| A8 | PT22A | 0 | | T | PT22A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F12 | PT21B | 0 | | C | PT21B | 0 | | C |
| E10 | PT21A | 0 | | T | PT21A | 0 | | T |
| G13 | PT20B | 0 | | C | PT20B | 0 | | C |
| C9 | PT20A | 0 | | T | PT20A | 0 | | T |
| B8 | PT19B | 0 | | C | PT19B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| A7 | PT19A | 0 | | T | PT19A | 0 | | T |
| D9 | PT18B | 0 | | C | PT18B | 0 | | C |
| H13 | PT18A | 0 | | T | PT18A | 0 | | T |
| D6 | PT17B | 0 | | C | PT17B | 0 | | C |
| C7 | PT17A | 0 | | T | PT17A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C8 | PT16B | 0 | | C | PT16B | 0 | | C |
| G12 | PT16A | 0 | | T | PT16A | 0 | | T |
| D8 | PT15B | 0 | | C | PT15B | 0 | | C |
| H12 | PT15A | 0 | | T | PT15A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| A6 | PT14B | 0 | | C | PT14B | 0 | | C |
| A5 | PT14A | 0 | | T | PT14A | 0 | | T |
| A4 | PT13B | 0 | | C | PT13B | 0 | | C |
| A3 | PT13A | 0 | | T | PT13A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C6 | PT12B | 0 | | C | PT12B | 0 | | C |
| F10 | PT12A | 0 | | T | PT12A | 0 | | T |
| D7 | PT11B | 0 | | C | PT11B | 0 | | C |
| H11 | PT11A | 0 | | T | PT11A | 0 | | T |
| D5 | PT10B | 0 | | C | PT10B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| E6 | PT10A | 0 | | T | PT10A | 0 | | T |
| G10 | PT9B | 0 | | C | PT9B | 0 | | C |
| F9 | PT9A | 0 | | T | PT9A | 0 | | T |
| H10 | PT8B | 0 | | C | PT8B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E7 | PT8A | 0 | | T | PT8A | 0 | | T |
| B3 | PT7B | 0 | | C | PT7B | 0 | | C |
| C5 | PT7A | 0 | | T | PT7A | 0 | | T |
| B2 | PT6B | 0 | | C | PT6B | 0 | | C |
| C4 | PT6A | 0 | | T | PT6A | 0 | | T |
| G9 | PT5B | 0 | | C | PT5B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| F7 | PT5A | 0 | | T | PT5A | 0 | | T |
| C3 | PT4B | 0 | | C | PT4B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D4 | PT4A | 0 | | T | PT4A | 0 | | T |
| J10 | PT3B | 0 | | C | PT3B | 0 | | C |
| F8 | PT3A | 0 | | T | PT3A | 0 | | T |
| G8 | PT2B | 0 | | C | PT2B | 0 | | C |
| G7 | PT2A | 0 | | T | PT2A | 0 | | T |
| L12 | VCC | - | | | VCC | - | | |
| L13 | VCC | - | | | VCC | - | | |
| L14 | VCC | - | | | VCC | - | | |
| L15 | VCC | - | | | VCC | - | | |
| M11 | VCC | - | | | VCC | - | | |
| M12 | VCC | - | | | VCC | - | | |
| M15 | VCC | - | | | VCC | - | | |
| M16 | VCC | - | | | VCC | - | | |
| N11 | VCC | - | | | VCC | - | | |
| N16 | VCC | - | | | VCC | - | | |
| P11 | VCC | - | | | VCC | - | | |
| P16 | VCC | - | | | VCC | - | | |
| R11 | VCC | - | | | VCC | - | | |
| R12 | VCC | - | | | VCC | - | | |
| R15 | VCC | - | | | VCC | - | | |
| R16 | VCC | - | | | VCC | - | | |
| T12 | VCC | - | | | VCC | - | | |
| T13 | VCC | - | | | VCC | - | | |
| T14 | VCC | - | | | VCC | - | | |
| T15 | VCC | - | | | VCC | - | | |
| B12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| B7 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F11 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| J13 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| K12 | VCCIO0 | 0 | | | VCCIO0 | 1 | | |
| D18 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F16 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| J14 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| K15 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G25 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L21 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M17 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M25 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| N18 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| P18 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R17 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R25 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| T21 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| Y25 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AA16 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC18 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| U15 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| V14 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AA11 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| V13 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AE12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AE7 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| U12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| P9 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R10 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| R2 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| T6 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y2 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| G2 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L6 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M2 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| N9 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| AC24 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| U17 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| J11 | VCCAUX | - | | | VCCAUX | - | | |
| J12 | VCCAUX | - | | | VCCAUX | - | | |
| J15 | VCCAUX | - | | | VCCAUX | - | | |
| J16 | VCCAUX | - | | | VCCAUX | - | | |
| L18 | VCCAUX | - | | | VCCAUX | - | | |
| L9 | VCCAUX | - | | | VCCAUX | - | | |
| M18 | VCCAUX | - | | | VCCAUX | - | | |
| M9 | VCCAUX | - | | | VCCAUX | - | | |
| R18 | VCCAUX | - | | | VCCAUX | - | | |
| R9 | VCCAUX | - | | | VCCAUX | - | | |
| T18 | VCCAUX | - | | | VCCAUX | - | | |
| T9 | VCCAUX | - | | | VCCAUX | - | | |
| V11 | VCCAUX | - | | | VCCAUX | - | | |
| V12 | VCCAUX | - | | | VCCAUX | - | | |
| V15 | VCCAUX | - | | | VCCAUX | - | | |
| V16 | VCCAUX | - | | | VCCAUX | - | | |
| A13 | GND | - | | | GND | - | | |
| A19 | GND | - | | | GND | - | | |
| A2 | GND | - | | | GND | - | | |
| A25 | GND | - | | | GND | - | | |
| AA2 | GND | - | | | GND | - | | |
| AA25 | GND | - | | | GND | - | | |
| AB18 | GND | - | | | GND | - | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AB22 | GND | - | | | GND | - | | |
| AB5 | GND | - | | | GND | - | | |
| AB9 | GND | - | | | GND | - | | |
| AE1 | GND | - | | | GND | - | | |
| AE11 | GND | - | | | GND | - | | |
| AE16 | GND | - | | | GND | - | | |
| AE22 | GND | - | | | GND | - | | |
| AE26 | GND | - | | | GND | - | | |
| AE6 | GND | - | | | GND | - | | |
| AF13 | GND | - | | | GND | - | | |
| AF19 | GND | - | | | GND | - | | |
| AF2 | GND | - | | | GND | - | | |
| AF25 | GND | - | | | GND | - | | |
| B1 | GND | - | | | GND | - | | |
| B11 | GND | - | | | GND | - | | |
| B16 | GND | - | | | GND | - | | |
| B22 | GND | - | | | GND | - | | |
| B26 | GND | - | | | GND | - | | |
| B6 | GND | - | | | GND | - | | |
| E18 | GND | - | | | GND | - | | |
| E22 | GND | - | | | GND | - | | |
| E5 | GND | - | | | GND | - | | |
| E9 | GND | - | | | GND | - | | |
| F2 | GND | - | | | GND | - | | |
| F25 | GND | - | | | GND | - | | |
| G11 | GND | - | | | GND | - | | |
| G16 | GND | - | | | GND | - | | |
| J22 | GND | - | | | GND | - | | |
| J5 | GND | - | | | GND | - | | |
| K11 | GND | - | | | GND | - | | |
| K13 | GND | - | | | GND | - | | |
| K14 | GND | - | | | GND | - | | |
| K16 | GND | - | | | GND | - | | |
| L10 | GND | - | | | GND | - | | |
| L11 | GND | - | | | GND | - | | |
| L16 | GND | - | | | GND | - | | |
| L17 | GND | - | | | GND | - | | |
| L2 | GND | - | | | GND | - | | |
| L20 | GND | - | | | GND | - | | |
| L25 | GND | - | | | GND | - | | |
| L7 | GND | - | | | GND | - | | |
| M13 | GND | - | | | GND | - | | |
| M14 | GND | - | | | GND | - | | |
| N10 | GND | - | | | GND | - | | |
| N12 | GND | - | | | GND | - | | |
| N13 | GND | - | | | GND | - | | |
| N14 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N17 | GND | - | | | GND | - | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| P10 | GND | - | | | GND | - | | |
| P12 | GND | - | | | GND | - | | |
| P13 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P15 | GND | - | | | GND | - | | |
| P17 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| R14 | GND | - | | | GND | - | | |
| T10 | GND | - | | | GND | - | | |
| T11 | GND | - | | | GND | - | | |
| T16 | GND | - | | | GND | - | | |
| T17 | GND | - | | | GND | - | | |
| T2 | GND | - | | | GND | - | | |
| T20 | GND | - | | | GND | - | | |
| T25 | GND | - | | | GND | - | | |
| T7 | GND | - | | | GND | - | | |
| U11 | GND | - | | | GND | - | | |
| U13 | GND | - | | | GND | - | | |
| U14 | GND | - | | | GND | - | | |
| U16 | GND | - | | | GND | - | | |
| V22 | GND | - | | | GND | - | | |
| V5 | GND | - | | | GND | - | | |
| Y11 | GND | - | | | GND | - | | |
| Y16 | GND | - | | | GND | - | | |
| AB3 | NC | - | | | NC | - | | |
| AB4 | NC | - | | | NC | - | | |
| AC1 | NC | - | | | NC | - | | |
| AC2 | NC | - | | | NC | - | | |
| B4 | NC | - | | | NC | - | | |
| B5 | NC | - | | | NC | - | | |
| C26 | NC | - | | | NC | - | | |
| D20 | NC | - | | | NC | - | | |
| D21 | NC | - | | | NC | - | | |
| D22 | NC | - | | | NC | - | | |
| D23 | NC | - | | | NC | - | | |
| D24 | NC | - | | | NC | - | | |
| D25 | NC | - | | | NC | - | | |
| D26 | NC | - | | | NC | - | | |
| E20 | NC | - | | | NC | - | | |
| E21 | NC | - | | | NC | - | | |
| E25 | NC | - | | | NC | - | | |
| E26 | NC | - | | | NC | - | | |
| F20 | NC | - | | | NC | - | | |
| G20 | NC | - | | | NC | - | | |
| K10 | NC | - | | | NC | - | | |
| K17 | NC | - | | | NC | - | | |
| R4 | NC | - | | | NC | - | | |
| U10 | NC | - | | | NC | - | | |
| U23 | NC | - | | | NC | - | | |

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

| LFE2M35E/SE | | | | | LFE2M50E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| V10 | NC | - | | | NC | - | | |
| W7 | NC | - | | | NC | - | | |
| AB21 | PB69B | 4 | BDQ69 | C | NC | - | | |
| AC20 | PB58A | 4 | BDQ60 | T | NC | - | | |
| AC21 | PB63A | 4 | BDQ60 | T | NC | - | | |
| AC22 | PB69A | 4 | BDQS69**** | T | NC | - | | |
| AC23 | PB71A | 4 | BDQ69 | T | NC | - | | |
| AC25 | PB71B | 4 | BDQ69 | C | NC | - | | |
| AD26 | PB70B | 4 | BDQ69 | C | NC | - | | |
| W20 | PB72B | 4 | BDQ69 | C | NC | - | | |
| H7 | L_VCCPLL | - | | | L_VCCPLL | - | | |
| K6 | L_VCCPLL | - | | | L_VCCPLL | - | | |
| P7 | L_VCCPLL | - | | | L_VCCPLL | - | | |
| R8 | L_VCCPLL | - | | | L_VCCPLL | - | | |
| V18 | R_VCCPLL | - | | | R_VCCPLL | - | | |
| P20 | R_VCCPLL | - | | | R_VCCPLL | - | | |
| J17 | R_VCCPLL | - | | | R_VCCPLL | - | | |
| G19 | R_VCCPLL | - | | | R_VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| D2 | PL9A | 7 | VREF2_7/LDQ6 | T | PL9A | 7 | VREF2_7 | T | |
| D3 | PL9B | 7 | VREF1_7/LDQ6 | C | PL9B | 7 | VREF1_7 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| J8 | PL11A | 7 | LUM0_SPLLT_IN_A | T (LVDS)* | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* | |
| H7 | PL11B | 7 | LUM0_SPLLC_IN_A | C (LVDS)* | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C (LVDS)* | |
| E3 | PL12A | 7 | LUM0_SPLLT_FB_A | T | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T | |
| E4 | PL12B | 7 | LUM0_SPLLC_FB_A | C | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C | |
| GNDIO | GNDIO7 | - | | | - | - | | | |
| G6 | PL13A | 7 | | T (LVDS)* | PL13A | 7 | LDQ15 | T (LVDS)* | |
| F5 | PL13B | 7 | | C (LVDS)* | PL13B | 7 | LDQ15 | C (LVDS)* | |
| E2 | PL14A | 7 | | T | PL14A | 7 | LDQ15 | T | |
| D1 | PL14B | 7 | | C | PL14B | 7 | LDQ15 | C | |
| - | - | - | | | GNDIO7 | - | | | |
| G5 | NC | - | | | PL15A | 7 | LDQS15 | T (LVDS)* | |
| G4 | NC | - | | | PL15B | 7 | LDQ15 | C (LVDS)* | |
| K7 | NC | - | | | PL16A | 7 | LDQ15 | T | |
| K8 | NC | - | | | PL16B | 7 | LDQ15 | C | |
| E1 | NC | - | | | PL17A | 7 | LDQ15 | T (LVDS)* | |
| F2 | NC | - | | | PL17B | 7 | LDQ15 | C (LVDS)* | |
| F1 | NC | - | | | PL18A | 7 | LDQ15 | T | |
| - | - | - | | | GNDIO7 | - | | | |
| G3 | NC | - | | | PL18B | 7 | LDQ15 | C | |
| H5 | PL15A | 7 | | T (LVDS)* | PL21A | 7 | | T (LVDS)* | |
| H4 | PL15B | 7 | | C (LVDS)* | PL21B | 7 | | C (LVDS)* | |
| J5 | PL16A | 7 | | T | PL22A | 7 | | T | |
| J4 | PL16B | 7 | | C | PL22B | 7 | | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| G2 | NC | - | | | PL24A | 7 | LDQ28 | T (LVDS)* | |
| G1 | NC | - | | | PL24B | 7 | LDQ28 | C (LVDS)* | |
| L9 | NC | - | | | PL25A | 7 | LDQ28 | T | |
| L7 | NC | - | | | PL25B | 7 | LDQ28 | C | |
| K6 | NC | - | | | PL26A | 7 | LDQ28 | T (LVDS)* | |
| K5 | NC | - | | | PL26B | 7 | LDQ28 | C (LVDS)* | |
| L8 | NC | - | | | PL27A | 7 | LDQ28 | T | |
| L6 | NC | - | | | PL27B | 7 | LDQ28 | C | |
| - | - | - | | | GNDIO7 | - | | | |
| H3 | PL18A | 7 | | T (LVDS)* | PL28A | 7 | LDQS28 | T (LVDS)* | |
| H2 | PL18B | 7 | | C (LVDS)* | PL28B | 7 | LDQ28 | C (LVDS)* | |
| N8 | PL19A | 7 | | T | PL29A | 7 | LDQ28 | T | |
| M9 | PL19B | 7 | | C | PL29B | 7 | LDQ28 | C | |
| J3 | PL20A | 7 | | T (LVDS)* | PL30A | 7 | LDQ28 | T (LVDS)* | |
| VCCIO | VCCIO7 | 7 | | | - | - | | | |
| J2 | PL20B | 7 | | C (LVDS)* | PL30B | 7 | LDQ28 | C (LVDS)* | |
| H1 | PL21A | 7 | | T | PL31A | 7 | LDQ28 | T | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| J1 | PL21B | 7 | | C | PL31B | 7 | LDQ28 | C | |
| - | - | - | | | - | - | | | |
| - | - | - | | | - | - | | | |
| L5 | PL23A | 7 | LDQ27 | T (LVDS)* | PL33A | 7 | LDQ37 | T (LVDS)* | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| L4 | PL23B | 7 | LDQ27 | C (LVDS)* | PL33B | 7 | LDQ37 | C (LVDS)* | |
| N9 | PL24A | 7 | LDQ27 | T | PL34A | 7 | LDQ37 | T | |
| N7 | PL24B | 7 | LDQ27 | C | PL34B | 7 | LDQ37 | C | |
| K2 | PL25A | 7 | LDQ27 | T (LVDS)* | PL35A | 7 | LDQ37 | T (LVDS)* | |
| K1 | PL25B | 7 | LDQ27 | C (LVDS)* | PL35B | 7 | LDQ37 | C (LVDS)* | |
| P9 | PL26A | 7 | LDQ27 | T | PL36A | 7 | LDQ37 | T | |
| P7 | PL26B | 7 | LDQ27 | C | PL36B | 7 | LDQ37 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| M6 | PL27A | 7 | LDQS27 | T (LVDS)* | PL37A | 7 | LDQS37 | T (LVDS)* | |
| M5 | PL27B | 7 | LDQ27 | C (LVDS)* | PL37B | 7 | LDQ37 | C (LVDS)* | |
| N5 | PL28A | 7 | LDQ27 | T | PL38A | 7 | LDQ37 | T | |
| N6 | PL28B | 7 | LDQ27 | C | PL38B | 7 | LDQ37 | C | |
| M4 | PL29A | 7 | LDQ27 | T (LVDS)* | PL39A | 7 | LDQ37 | T (LVDS)* | |
| M3 | PL29B | 7 | LDQ27 | C (LVDS)* | PL39B | 7 | LDQ37 | C (LVDS)* | |
| P6 | PL30A | 7 | LDQ27 | T | PL40A | 7 | LDQ37 | T | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| P8 | PL30B | 7 | LDQ27 | C | PL40B | 7 | LDQ37 | C | |
| L3 | PL32A | 7 | LUM3_SPLLT_IN_A/LDQ36 | T (LVDS)* | PL42A | 7 | LUM3_SPLLT_IN_A/LDQ46 | T (LVDS)* | |
| L2 | PL32B | 7 | LUM3_SPLLC_IN_A/LDQ36 | C (LVDS)* | PL42B | 7 | LUM3_SPLLC_IN_A/LDQ46 | C (LVDS)* | |
| P5 | PL33A | 7 | LUM3_SPLLT_FB_A/LDQ36 | T | PL43A | 7 | LUM3_SPLLT_FB_A/LDQ46 | T | |
| P4 | PL33B | 7 | LUM3_SPLLC_FB_A/LDQ36 | C | PL43B | 7 | LUM3_SPLLC_FB_A/LDQ46 | C | |
| L1 | PL34A | 7 | LDQ36 | T (LVDS)* | PL44A | 7 | LDQ46 | T (LVDS)* | |
| M2 | PL34B | 7 | LDQ36 | C (LVDS)* | PL44B | 7 | LDQ46 | C (LVDS)* | |
| R5 | PL35A | 7 | LDQ36 | T | PL45A | 7 | LDQ46 | T | |
| R4 | PL35B | 7 | LDQ36 | C | PL45B | 7 | LDQ46 | C | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| M1 | PL36A | 7 | LDQS36 | T (LVDS)* | PL46A | 7 | LDQS46 | T (LVDS)* | |
| N2 | PL36B | 7 | LDQ36 | C (LVDS)* | PL46B | 7 | LDQ46 | C (LVDS)* | |
| R8 | PL37A | 7 | LDQ36 | T | PL47A | 7 | LDQ46 | T | |
| T9 | PL37B | 7 | LDQ36 | C | PL47B | 7 | LDQ46 | C | |
| P3 | PL38A | 7 | LDQ36 | T (LVDS)* | PL48A | 7 | LDQ46 | T (LVDS)* | |
| P2 | PL38B | 7 | LDQ36 | C (LVDS)* | PL48B | 7 | LDQ46 | C (LVDS)* | |
| N1 | PL39A | 7 | PCLKT7_0/LDQ36 | T | PL49A | 7 | PCLKT7_0/LDQ46 | T | |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | | |
| P1 | PL39B | 7 | PCLKC7_0/LDQ36 | C | PL49B | 7 | PCLKC7_0/LDQ46 | C | |
| T5 | PL41A | 6 | PCLKT6_0 | T (LVDS)* | PL51A | 6 | PCLKT6_0/LDQ55 | T (LVDS)* | |
| T4 | PL41B | 6 | PCLKC6_0 | C (LVDS)* | PL51B | 6 | PCLKC6_0/LDQ55 | C (LVDS)* | |
| U7 | PL42A | 6 | VREF2_6 | T | PL52A | 6 | VREF2_6/LDQ55 | T | |
| T8 | PL42B | 6 | VREF1_6 | C | PL52B | 6 | VREF1_6/LDQ55 | C | |
| R3 | PL43A | 6 | | T (LVDS)* | PL53A | 6 | LDQ55 | T (LVDS)* | |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | | |
| R2 | PL43B | 6 | | C (LVDS)* | PL53B | 6 | LDQ55 | C (LVDS)* | |
| R1 | PL44A | 6 | | T | PL54A | 6 | LDQ55 | T | |
| T1 | PL44B | 6 | | C | PL54B | 6 | LDQ55 | C | |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | | |
| - | - | - | | | VCCIO6 | 6 | | | |
| T3 | PL45A | 6 | LLM3_SPLLT_IN_A | T (LVDS)* | PL57A | 6 | LLM3_SPLLT_IN_A/LDQ55 | T (LVDS)* | |
| T2 | PL45B | 6 | LLM3_SPLLC_IN_A | C (LVDS)* | PL57B | 6 | LLM3_SPLLC_IN_A/LDQ55 | C (LVDS)* | |
| U9 | PL46A | 6 | LLM3_SPLLT_FB_A | T | PL58A | 6 | LLM3_SPLLT_FB_A/LDQ55 | T | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| U8 | PL46B | 6 | LLM3_SPLLC_FB_A | C | PL58B | 6 | LLM3_SPLLC_FB_A/LDQ55 | C |
| VCCIO | VCCIO6 | 6 | | | GNDIO6 | - | | |
| U5 | PL48A | 6 | LDQ52 | T (LVDS)* | PL60A | 6 | LDQ64 | T (LVDS)* |
| U4 | PL48B | 6 | LDQ52 | C (LVDS)* | PL60B | 6 | LDQ64 | C (LVDS)* |
| V9 | PL49A | 6 | LDQ52 | T | PL61A | 6 | LDQ64 | T |
| V7 | PL49B | 6 | LDQ52 | C | PL61B | 6 | LDQ64 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| U3 | PL50A | 6 | LDQ52 | T (LVDS)* | PL62A | 6 | LDQ64 | T (LVDS)* |
| U2 | PL50B | 6 | LDQ52 | C (LVDS)* | PL62B | 6 | LDQ64 | C (LVDS)* |
| V8 | PL51A | 6 | LDQ52 | T | PL63A | 6 | LDQ64 | T |
| U6 | PL51B | 6 | LDQ52 | C | PL63B | 6 | LDQ64 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| U1 | PL52A | 6 | LDQS52 | T (LVDS)* | PL64A | 6 | LDQS64 | T (LVDS)* |
| V2 | PL52B | 6 | LDQ52 | C (LVDS)* | PL64B | 6 | LDQ64 | C (LVDS)* |
| V5 | PL53A | 6 | LDQ52 | T | PL65A | 6 | LDQ64 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V6 | PL53B | 6 | LDQ52 | C | PL65B | 6 | LDQ64 | C |
| V1 | PL54A | 6 | LDQ52 | T (LVDS)* | PL66A | 6 | LDQ64 | T (LVDS)* |
| W1 | PL54B | 6 | LDQ52 | C (LVDS)* | PL66B | 6 | LDQ64 | C (LVDS)* |
| W5 | PL55A | 6 | LDQ52 | T | PL67A | 6 | LDQ64 | T |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| W6 | PL55B | 6 | LDQ52 | C | PL67B | 6 | LDQ64 | C |
| W3 | PL57A | 6 | | T (LVDS)* | PL69A | 6 | LDQ73 | T (LVDS)* |
| W4 | PL57B | 6 | | C (LVDS)* | PL69B | 6 | LDQ73 | C (LVDS)* |
| W2 | PL58A | 6 | | T | PL70A | 6 | LDQ73 | T |
| Y4 | PL58B | 6 | | C | PL70B | 6 | LDQ73 | C |
| Y1 | PL59A | 6 | | T (LVDS)* | PL71A | 6 | LDQ73 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y2 | PL59B | 6 | | C (LVDS)* | PL71B | 6 | LDQ73 | C (LVDS)* |
| Y5 | PL60A | 6 | | T | PL72A | 6 | LDQ73 | T |
| Y6 | PL60B | 6 | | C | PL72B | 6 | LDQ73 | C |
| AA1 | NC | - | | | PL73A | 6 | LDQS73 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AA2 | NC | - | | | PL73B | 6 | LDQ73 | C (LVDS)* |
| Y3 | NC | - | | | PL74A | 6 | LDQ73 | T |
| AB1 | NC | - | | | PL74B | 6 | LDQ73 | C |
| - | - | - | | | VCCIO6 | 6 | | |
| Y9 | NC | - | | | PL75A | 6 | LDQ73 | T (LVDS)* |
| Y8 | NC | - | | | PL75B | 6 | LDQ73 | C (LVDS)* |
| Y7 | NC | - | | | PL76A | 6 | LDQ73 | T |
| AA7 | NC | - | | | PL76B | 6 | LDQ73 | C |
| - | - | - | | | GNDIO6 | - | | |
| - | - | - | | | - | - | | |
| AB2 | NC | - | | | PL78A | 6 | LDQ82 | T (LVDS)* |
| AB3 | NC | - | | | PL78B | 6 | LDQ82 | C (LVDS)* |
| AA5 | NC | - | | | PL79A | 6 | LDQ82 | T |
| AA6 | NC | - | | | PL79B | 6 | LDQ82 | C |
| AB4 | NC | - | | | PL80A | 6 | LDQ82 | T (LVDS)* |
| - | - | - | | | VCCIO6 | 6 | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|-------------------|--------------|-------------------|------|--------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AB5 | NC | - | | | PL80B | 6 | LDQ82 | C (LVDS)* |
| AA8 | NC | - | | | PL81A | 6 | LDQ82 | T |
| AA9 | NC | - | | | PL81B | 6 | LDQ82 | C |
| AC1 | PL62A | 6 | LLM0_GPLLT_IN_A** | T (LVDS)* | PL82A | 6 | LLM0_GPLLT_IN_A**/LDQS82 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AC2 | PL62B | 6 | LLM0_GPLLC_IN_A** | C (LVDS)* | PL82B | 6 | LLM0_GPLLC_IN_A**/LDQ82 | C (LVDS)* |
| AC4 | PL63A | 6 | LLM0_GPLLT_FB_A | T | PL83A | 6 | LLM0_GPLLT_FB_A/LDQ82 | T |
| AC3 | PL63B | 6 | LLM0_GPLLC_FB_A | C | PL83B | 6 | LLM0_GPLLC_FB_A/LDQ82 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AC7 | PL64A | 6 | LLM0_GDLLT_IN_A** | T (LVDS)* | PL84A | 6 | LLM0_GDLLT_IN_A**/LDQ82 | T (LVDS)* |
| AC6 | PL64B | 6 | LLM0_GDLLC_IN_A** | C (LVDS)* | PL84B | 6 | LLM0_GDLLC_IN_A**/LDQ82 | C (LVDS)* |
| AC5 | PL65A | 6 | LLM0_GDLLT_FB_A | T | PL85A | 6 | LLM0_GDLLT_FB_A/LDQ82 | T |
| AD3 | PL65B | 6 | LLM0_GDLLC_FB_A | C | PL85B | 6 | LLM0_GDLLC_FB_A/LDQ82 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AB8 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | |
| AD2 | PL67A | 6 | LDQ71 | T (LVDS)* | PL87A | 6 | | T |
| AD1 | PL67B | 6 | LDQ71 | C (LVDS)* | PL87B | 6 | | C |
| AE2 | TCK | - | | | TCK | - | | |
| AE1 | TDI | - | | | TDI | - | | |
| AF2 | TMS | - | | | TMS | - | | |
| AF1 | TDO | - | | | TDO | - | | |
| AG1 | VCCJ | - | | | VCCJ | - | | |
| AH1 | VCC | - | | | LLC_SQ_VCCRX3 | 14 | | |
| AK2 | PB11A | 5 | BDQ15 | T | LLC_SQ_HDINP3 | 14 | | T |
| AJ1 | NC | - | | | LLC_SQ_VCCIB3 | 14 | | |
| AJ2 | PB11B | 5 | BDQ15 | C | LLC_SQ_HDINN3 | 14 | | C |
| AH4 | VCC | - | | | LLC_SQ_VCCTX3 | 14 | | |
| AK5 | PB13A | 5 | BDQ15 | T | LLC_SQ_HDOUTP3 | 14 | | T |
| AK4 | NC | - | | | LLC_SQ_VCCOB3 | 14 | | |
| AJ5 | PB13B | 5 | BDQ15 | C | LLC_SQ_HDOUTN3 | 14 | | C |
| AH5 | VCC | - | | | LLC_SQ_VCCTX2 | 14 | | |
| AJ6 | PB14B | 5 | BDQ15 | C | LLC_SQ_HDOUTN2 | 14 | | C |
| AH6 | NC | - | | | LLC_SQ_VCCOB2 | 14 | | |
| AK6 | PB14A | 5 | BDQ15 | T | LLC_SQ_HDOUTP2 | 14 | | T |
| AH2 | VCC | - | | | LLC_SQ_VCCRX2 | 14 | | |
| AJ3 | PB12B | 5 | BDQ15 | C | LLC_SQ_HDINN2 | 14 | | C |
| AH3 | NC | - | | | LLC_SQ_VCCIB2 | 14 | | |
| AK3 | PB12A | 5 | BDQ15 | T | LLC_SQ_HDINP2 | 14 | | T |
| AH7 | VCC | - | | | LLC_SQ_VCCP | 14 | | |
| AG7 | PB15A | 5 | BDQS15 | T | LLC_SQ_REFCLKP | 14 | | T |
| AF7 | PB15B | 5 | BDQ15 | C | LLC_SQ_REFCLKN | 14 | | C |
| AJ7 | VCCAUX | - | | | LLC_SQ_VCCAUX33 | 14 | | |
| AK11 | PB18A | 5 | BDQ15 | T | LLC_SQ_HDINP1 | 14 | | T |
| AH11 | NC | - | | | LLC_SQ_VCCIB1 | 14 | | |
| AJ11 | PB18B | 5 | BDQ15 | C | LLC_SQ_HDINN1 | 14 | | C |
| AH12 | VCC | - | | | LLC_SQ_VCCRX1 | 14 | | |
| AK8 | PB16A | 5 | BDQ15 | T | LLC_SQ_HDOUTP1 | 14 | | T |
| AH8 | NC | - | | | LLC_SQ_VCCOB1 | 14 | | |
| AJ8 | PB16B | 5 | BDQ15 | C | LLC_SQ_HDOUTN1 | 14 | | C |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AH9 | VCC | - | | | LLC_SQ_VCCTX1 | 14 | | | |
| AJ9 | PB17B | 5 | BDQ15 | C | LLC_SQ_HDOOUTN0 | 14 | | C | |
| AK10 | NC | - | | | LLC_SQ_VCCOB0 | 14 | | | |
| AK9 | PB17A | 5 | BDQ15 | T | LLC_SQ_HDOOUTP0 | 14 | | T | |
| AH10 | VCC | - | | | LLC_SQ_VCCTX0 | 14 | | | |
| AJ12 | PB19B | 5 | BDQ15 | C | LLC_SQ_HDINN0 | 14 | | C | |
| AJ13 | NC | - | | | LLC_SQ_VCCIB0 | 14 | | | |
| AK12 | PB19A | 5 | BDQ15 | T | LLC_SQ_HDINP0 | 14 | | T | |
| AH13 | VCC | - | | | LLC_SQ_VCCRX0 | 14 | | | |
| AF10 | PB3A | 5 | BDQ6 | T | PB30A | 5 | BDQ33 | T | |
| AE8 | PB3B | 5 | BDQ6 | C | PB30B | 5 | BDQ33 | C | |
| AE11 | PB4A | 5 | BDQ6 | T | PB31A | 5 | BDQ33 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AD9 | PB4B | 5 | BDQ6 | C | PB31B | 5 | BDQ33 | C | |
| AE10 | PB5A | 5 | BDQ6 | T | PB32A | 5 | BDQ33 | T | |
| AD10 | PB5B | 5 | BDQ6 | C | PB32B | 5 | BDQ33 | C | |
| AE13 | PB6A | 5 | BDQS6 | T | PB33A | 5 | BDQS33 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AC12 | PB6B | 5 | BDQ6 | C | PB33B | 5 | BDQ33 | C | |
| AG2 | PB7A | 5 | BDQ6 | T | PB34A | 5 | BDQ33 | T | |
| AG3 | PB7B | 5 | BDQ6 | C | PB34B | 5 | BDQ33 | C | |
| AD13 | PB8A | 5 | BDQ6 | T | PB35A | 5 | BDQ33 | T | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AC13 | PB8B | 5 | BDQ6 | C | PB35B | 5 | BDQ33 | C | |
| AE14 | PB9A | 5 | BDQ6 | T | PB36A | 5 | BDQ33 | T | |
| AC14 | PB9B | 5 | BDQ6 | C | PB36B | 5 | BDQ33 | C | |
| AF3 | PB10A | 5 | BDQ6 | T | PB37A | 5 | BDQ33 | T | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AF4 | PB10B | 5 | BDQ6 | C | PB37B | 5 | BDQ33 | C | |
| VCCIO | VCCIO5 | 5 | | | - | - | | | |
| AG4 | PB20A | 5 | BDQ24 | T | PB38A | 5 | BDQ42 | T | |
| AG5 | PB20B | 5 | BDQ24 | C | PB38B | 5 | BDQ42 | C | |
| GNDIO | GNDIO5 | - | | | - | - | | | |
| VCCIO | VCCIO5 | 5 | | | - | - | | | |
| AD11 | PB24A | 5 | BDQS24**** | T | PB39A | 5 | BDQ42 | T | |
| AF13 | PB24B | 5 | BDQ24 | C | PB39B | 5 | BDQ42 | C | |
| AF12 | PB25A | 5 | BDQ24 | T | PB40A | 5 | BDQ42 | T | |
| - | - | - | | | VCCIO5 | 5 | | | |
| AD14 | PB25B | 5 | BDQ24 | C | PB40B | 5 | BDQ42 | C | |
| AG8 | PB26A | 5 | BDQ24 | T | PB41A | 5 | BDQ42 | T | |
| AF8 | PB26B | 5 | BDQ24 | C | PB41B | 5 | BDQ42 | C | |
| AE15 | PB27A | 5 | BDQ24 | T | PB42A | 5 | BDQS42**** | T | |
| - | - | - | | | GNDIO5 | - | | | |
| VCCIO | VCCIO5 | 5 | | | - | - | | | |
| AC15 | PB27B | 5 | BDQ24 | C | PB42B | 5 | BDQ42 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AD15 | PB38A | 5 | BDQ42 | T | PB47A | 5 | BDQ51 | T | |
| AF15 | PB38B | 5 | BDQ42 | C | PB47B | 5 | BDQ51 | C | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AG10 | PB39A | 5 | BDQ42 | T | PB48A | 5 | BDQ51 | T | |
| AG9 | PB39B | 5 | BDQ42 | C | PB48B | 5 | BDQ51 | C | |
| AH14 | PB40A | 5 | BDQ42 | T | PB49A | 5 | BDQ51 | T | |
| AG12 | PB40B | 5 | BDQ42 | C | PB49B | 5 | BDQ51 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| AG15 | PB41A | 5 | BDQ42 | T | PB50A | 5 | BDQ51 | T | |
| AG13 | PB41B | 5 | BDQ42 | C | PB50B | 5 | BDQ51 | C | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AF16 | PB42A | 5 | BDQS42 | T | PB51A | 5 | BDQS51 | T | |
| AH15 | PB42B | 5 | BDQ42 | C | PB51B | 5 | BDQ51 | C | |
| AC16 | PB43A | 5 | VREF2_5/BDQ42 | T | PB52A | 5 | VREF2_5/BDQ51 | T | |
| AE16 | PB43B | 5 | VREF1_5/BDQ42 | C | PB52B | 5 | VREF1_5/BDQ51 | C | |
| AG11 | PB44A | 5 | PCLKT5_0/BDQ42 | T | PB53A | 5 | PCLKT5_0/BDQ51 | T | |
| AF11 | PB44B | 5 | PCLKC5_0/BDQ42 | C | PB53B | 5 | PCLKC5_0/BDQ51 | C | |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | | |
| AJ14 | PB49A | 4 | PCLKT4_0/BDQ51 | T | PB58A | 4 | PCLKT4_0/BDQ60 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AK14 | PB49B | 4 | PCLKC4_0/BDQ51 | C | PB58B | 4 | PCLKC4_0/BDQ60 | C | |
| AK15 | PB50A | 4 | VREF2_4/BDQ51 | T | PB59A | 4 | VREF2_4/BDQ60 | T | |
| AK16 | PB50B | 4 | VREF1_4/BDQ51 | C | PB59B | 4 | VREF1_4/BDQ60 | C | |
| AF18 | PB51A | 4 | BDQS51 | T | PB60A | 4 | BDQS60 | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AD16 | PB51B | 4 | BDQ51 | C | PB60B | 4 | BDQ60 | C | |
| AJ15 | PB52A | 4 | BDQ51 | T | PB61A | 4 | BDQ60 | T | |
| AG16 | PB52B | 4 | BDQ51 | C | PB61B | 4 | BDQ60 | C | |
| AE17 | PB53A | 4 | BDQ51 | T | PB62A | 4 | BDQ60 | T | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AC17 | PB53B | 4 | BDQ51 | C | PB62B | 4 | BDQ60 | C | |
| AH16 | PB54A | 4 | BDQ51 | T | PB63A | 4 | BDQ60 | T | |
| AK17 | PB54B | 4 | BDQ51 | C | PB63B | 4 | BDQ60 | C | |
| AG20 | PB55A | 4 | BDQ51 | T | PB64A | 4 | BDQ60 | T | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AG21 | PB55B | 4 | BDQ51 | C | PB64B | 4 | BDQ60 | C | |
| AG18 | PB56A | 4 | BDQ60 | T | PB65A | 4 | BDQ69 | T | |
| AJ16 | PB56B | 4 | BDQ60 | C | PB65B | 4 | BDQ69 | C | |
| AF21 | PB57A | 4 | BDQ60 | T | PB66A | 4 | BDQ69 | T | |
| AG22 | PB57B | 4 | BDQ60 | C | PB66B | 4 | BDQ69 | C | |
| AD17 | PB58A | 4 | BDQ60 | T | PB67A | 4 | BDQ69 | T | |
| AF19 | PB58B | 4 | BDQ60 | C | PB67B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AH17 | PB62A | 4 | BDQ60 | T | PB71A | 4 | BDQ69 | T | |
| AJ17 | PB62B | 4 | BDQ60 | C | PB71B | 4 | BDQ69 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AF26 | PB64A | 4 | BDQ60 | T | PB73A | 4 | BDQ69 | T | |
| AE25 | PB64B | 4 | BDQ60 | C | PB73B | 4 | BDQ69 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AD24 | PB65A | 4 | BDQ69 | T | PB74A | 4 | BDQ78 | T | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| AE24 | PB65B | 4 | BDQ69 | C | PB74B | 4 | BDQ78 | C | |
| AD18 | PB66A | 4 | BDQ69 | T | PB75A | 4 | BDQ78 | T | |
| AC18 | PB66B | 4 | BDQ69 | C | PB75B | 4 | BDQ78 | C | |
| AE18 | PB67A | 4 | BDQ69 | T | PB76A | 4 | BDQ78 | T | |
| AG19 | PB67B | 4 | BDQ69 | C | PB76B | 4 | BDQ78 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AC19 | PB69A | 4 | BDQS69 | T | PB78A | 4 | BDQS78 | T | |
| AD20 | PB69B | 4 | BDQ69 | C | PB78B | 4 | BDQ78 | C | |
| AB18 | PB70A | 4 | BDQ69 | T | PB79A | 4 | BDQ78 | T | |
| AC20 | PB70B | 4 | BDQ69 | C | PB79B | 4 | BDQ78 | C | |
| AE20 | PB71A | 4 | BDQ69 | T | PB80A | 4 | BDQ78 | T | |
| AE21 | PB71B | 4 | BDQ69 | C | PB80B | 4 | BDQ78 | C | |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | | |
| AC23 | PB72A | 4 | BDQ69 | T | PB81A | 4 | BDQ78 | T | |
| AD23 | PB72B | 4 | BDQ69 | C | PB81B | 4 | BDQ78 | C | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | | |
| AH18 | LRC_SQ_VCCR3 | 13 | | | LRC_SQ_VCCR3 | 13 | | | |
| AK19 | LRC_SQ_HDINP3 | 13 | | T | LRC_SQ_HDINP3 | 13 | | T | |
| AJ18 | LRC_SQ_VCCIB3 | 13 | | | LRC_SQ_VCCIB3 | 13 | | | |
| AJ19 | LRC_SQ_HDINN3 | 13 | | C | LRC_SQ_HDINN3 | 13 | | C | |
| AH21 | LRC_SQ_VCCTX3 | 13 | | | LRC_SQ_VCCTX3 | 13 | | | |
| AK22 | LRC_SQ_HDOU3 | 13 | | T | LRC_SQ_HDOU3 | 13 | | T | |
| AK21 | LRC_SQ_VCCOB3 | 13 | | | LRC_SQ_VCCOB3 | 13 | | | |
| AJ22 | LRC_SQ_HDOU3N3 | 13 | | C | LRC_SQ_HDOU3N3 | 13 | | C | |
| AH22 | LRC_SQ_VCCTX2 | 13 | | | LRC_SQ_VCCTX2 | 13 | | | |
| AJ23 | LRC_SQ_HDOU2N2 | 13 | | C | LRC_SQ_HDOU2N2 | 13 | | C | |
| AH23 | LRC_SQ_VCCOB2 | 13 | | | LRC_SQ_VCCOB2 | 13 | | | |
| AK23 | LRC_SQ_HDOU2 | 13 | | T | LRC_SQ_HDOU2 | 13 | | T | |
| AH19 | LRC_SQ_VCCR2 | 13 | | | LRC_SQ_VCCR2 | 13 | | | |
| AJ20 | LRC_SQ_HDINN2 | 13 | | C | LRC_SQ_HDINN2 | 13 | | C | |
| AH20 | LRC_SQ_VCCIB2 | 13 | | | LRC_SQ_VCCIB2 | 13 | | | |
| AK20 | LRC_SQ_HDINP2 | 13 | | T | LRC_SQ_HDINP2 | 13 | | T | |
| AH24 | LRC_SQ_VCCP | 13 | | | LRC_SQ_VCCP | 13 | | | |
| AG24 | LRC_SQ_REFCLKP | 13 | | T | LRC_SQ_REFCLKP | 13 | | T | |
| AF24 | LRC_SQ_REFCLKN | 13 | | C | LRC_SQ_REFCLKN | 13 | | C | |
| AJ24 | LRC_SQ_VCCAUX33 | 13 | | | LRC_SQ_VCCAUX33 | 13 | | | |
| AK28 | LRC_SQ_HDINP1 | 13 | | T | LRC_SQ_HDINP1 | 13 | | T | |
| AH28 | LRC_SQ_VCCIB1 | 13 | | | LRC_SQ_VCCIB1 | 13 | | | |
| AJ28 | LRC_SQ_HDINN1 | 13 | | C | LRC_SQ_HDINN1 | 13 | | C | |
| AH29 | LRC_SQ_VCCR1 | 13 | | | LRC_SQ_VCCR1 | 13 | | | |
| AK25 | LRC_SQ_HDOU1 | 13 | | T | LRC_SQ_HDOU1 | 13 | | T | |
| AH25 | LRC_SQ_VCCOB1 | 13 | | | LRC_SQ_VCCOB1 | 13 | | | |
| AJ25 | LRC_SQ_HDOU1N1 | 13 | | C | LRC_SQ_HDOU1N1 | 13 | | C | |
| AH26 | LRC_SQ_VCCTX1 | 13 | | | LRC_SQ_VCCTX1 | 13 | | | |
| AJ26 | LRC_SQ_HDOU0N0 | 13 | | C | LRC_SQ_HDOU0N0 | 13 | | C | |
| AK27 | LRC_SQ_VCCOB0 | 13 | | | LRC_SQ_VCCOB0 | 13 | | | |
| AK26 | LRC_SQ_HDOU0 | 13 | | T | LRC_SQ_HDOU0 | 13 | | T | |
| AH27 | LRC_SQ_VCCTX0 | 13 | | | LRC_SQ_VCCTX0 | 13 | | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|--------------------------|------|--------------------|--------------|--------------------------|------|--------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AJ29 | LRC_SQ_HDINN0 | 13 | | C | LRC_SQ_HDINN0 | 13 | | C |
| AJ30 | LRC_SQ_VCCIB0 | 13 | | | LRC_SQ_VCCIB0 | 13 | | |
| AK29 | LRC_SQ_HDINP0 | 13 | | T | LRC_SQ_HDINP0 | 13 | | T |
| AH30 | LRC_SQ_VCCRX0 | 13 | | | LRC_SQ_VCCRX0 | 13 | | |
| AG27 | CFG2 | 8 | | | CFG2 | 8 | | |
| AD25 | CFG1 | 8 | | | CFG1 | 8 | | |
| AG28 | CFG0 | 8 | | | CFG0 | 8 | | |
| AG30 | PROGRAMN | 8 | | | PROGRAMN | 8 | | |
| AG29 | CCLK | 8 | | | CCLK | 8 | | |
| AC24 | INITN | 8 | | | INITN | 8 | | |
| AF27 | DONE | 8 | | | DONE | 8 | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| AF28 | WRITEN*** | 8 | | | WRITEN*** | 8 | | |
| AE26 | CS1N*** | 8 | | | CS1N*** | 8 | | |
| AB23 | CSN*** | 8 | | | CSN*** | 8 | | |
| AF29 | D0/SPIFASTN*** | 8 | | | D0/SPIFASTN*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AF30 | D1*** | 8 | | | D1*** | 8 | | |
| AD26 | D2*** | 8 | | | D2*** | 8 | | |
| AE29 | D3*** | 8 | | | D3*** | 8 | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| AE30 | D4*** | 8 | | | D4*** | 8 | | |
| AD29 | D5*** | 8 | | | D5*** | 8 | | |
| AC25 | D6*** | 8 | | | D6*** | 8 | | |
| AD30 | D7/SPID0*** | 8 | | | D7/SPID0*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AA22 | DI/CSSPI0N*** | 8 | | | DI/CSSPI0N*** | 8 | | |
| AC26 | DOUT/CSON/ CSSPI1N*** | 8 | | | DOUT/CSON/ CSSPI1N*** | 8 | | |
| AA23 | BUSY/SISPI*** | 8 | | | BUSY/SISPI*** | 8 | | |
| AB22 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| AC27 | PR65B | 3 | RLM0_GDLLC_FB_A | C | PR65B | 3 | RLM0_GDLLC_FB_A/RDQ82 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| AC28 | PR65A | 3 | RLM0_GDLLT_FB_A | T | PR65A | 3 | RLM0_GDLLT_FB_A/RDQ82 | T |
| AC29 | PR64B | 3 | RLM0_GDLLC_IN_A** | C (LVDS)* | PR64B | 3 | RLM0_GDLLC_IN_A**/RDQ82 | C (LVDS)* |
| AC30 | PR64A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* | PR64A | 3 | RLM0_GDLLT_IN_A**/RDQ82 | T (LVDS)* |
| AB30 | PR63B | 3 | RLM0_GPLL_C_IN_A** | C | PR63B | 3 | RLM0_GPLL_C_IN_A**/RDQ82 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AA30 | PR63A | 3 | RLM0_GPLLT_IN_A** | T | PR63A | 3 | RLM0_GPLLT_IN_A**/RDQ82 | T |
| AB29 | PR62B | 3 | RLM0_GPLL_C_FB_A | C (LVDS)* | PR62B | 3 | RLM0_GPLL_C_FB_A/RDQ82 | C (LVDS)* |
| AB28 | PR62A | 3 | RLM0_GPLLT_FB_A | T (LVDS)* | PR62A | 3 | RLM0_GPLLT_FB_A/RDQ82 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| Y22 | PR60B | 3 | | C | PR61B | 3 | RDQ82 | C |
| Y23 | PR60A | 3 | | T | PR61A | 3 | RDQ82 | T |
| AB26 | NC | - | | | PR60B | 3 | RDQ82 | C (LVDS)* |
| AB27 | NC | - | | | PR60A | 3 | RDQ82 | T (LVDS)* |
| - | - | - | | | VCCIO3 | 3 | | |
| Y24 | NC | - | | | PR79B | 3 | RDQ82 | C |
| Y25 | NC | - | | | PR79A | 3 | RDQ82 | T |
| AA29 | NC | - | | | PR78B | 3 | RDQ82 | C (LVDS)* |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| Y28 | NC | - | | | PR78A | 3 | RDQ82 | T (LVDS)* |
| Y30 | NC | - | | | PR76B | 3 | RDQ73 | C |
| Y29 | NC | - | | | PR76A | 3 | RDQ73 | T |
| - | - | - | | | GNDIO3 | - | | |
| - | - | - | | | - | - | | |
| W22 | NC | - | | | PR75B | 3 | RDQ73 | C (LVDS)* |
| V22 | NC | - | | | PR75A | 3 | RDQ73 | T (LVDS)* |
| Y27 | NC | - | | | PR74B | 3 | RDQ73 | C |
| - | - | - | | | VCCIO3 | 3 | | |
| Y26 | NC | - | | | PR74A | 3 | RDQ73 | T |
| W30 | NC | - | | | PR73B | 3 | RDQ73 | C (LVDS)* |
| W29 | NC | - | | | PR73A | 3 | RDQS73 | T (LVDS)* |
| - | - | - | | | GNDIO3 | - | | |
| W25 | NC | - | | | PR72B | 3 | RDQ73 | C |
| W26 | NC | - | | | PR72A | 3 | RDQ73 | T |
| U29 | PR59B | 3 | | C (LVDS)* | PR71B | 3 | RDQ73 | C (LVDS)* |
| V29 | PR59A | 3 | | T (LVDS)* | PR71A | 3 | RDQ73 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| V30 | PR58B | 3 | | C | PR70B | 3 | RDQ73 | C |
| U30 | PR58A | 3 | | T | PR70A | 3 | RDQ73 | T |
| W27 | PR57B | 3 | | C (LVDS)* | PR69B | 3 | RDQ73 | C (LVDS)* |
| W28 | PR57A | 3 | | T (LVDS)* | PR69A | 3 | RDQ73 | T (LVDS)* |
| V24 | PR55B | 3 | RDQ52 | C | PR67B | 3 | RDQ64 | C |
| V25 | PR55A | 3 | RDQ52 | T | PR67A | 3 | RDQ64 | T |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| U28 | PR54B | 3 | RDQ52 | C (LVDS)* | PR66B | 3 | RDQ64 | C (LVDS)* |
| U27 | PR54A | 3 | RDQ52 | T (LVDS)* | PR66A | 3 | RDQ64 | T (LVDS)* |
| U23 | PR53B | 3 | RDQ52 | C | PR65B | 3 | RDQ64 | C |
| V23 | PR53A | 3 | RDQ52 | T | PR65A | 3 | RDQ64 | T |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| V26 | PR52B | 3 | RDQ52 | C (LVDS)* | PR64B | 3 | RDQ64 | C (LVDS)* |
| U26 | PR52A | 3 | RDQS52 | T (LVDS)* | PR64A | 3 | RDQS64 | T (LVDS)* |
| U25 | PR51B | 3 | RDQ52 | C | PR63B | 3 | RDQ64 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| U24 | PR51A | 3 | RDQ52 | T | PR63A | 3 | RDQ64 | T |
| T30 | PR50B | 3 | RDQ52 | C (LVDS)* | PR62B | 3 | RDQ64 | C (LVDS)* |
| R30 | PR50A | 3 | RDQ52 | T (LVDS)* | PR62A | 3 | RDQ64 | T (LVDS)* |
| T23 | PR49B | 3 | RDQ52 | C | PR61B | 3 | RDQ64 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| T22 | PR49A | 3 | RDQ52 | T | PR61A | 3 | RDQ64 | T |
| T29 | PR48B | 3 | RDQ52 | C (LVDS)* | PR60B | 3 | RDQ64 | C (LVDS)* |
| T28 | PR48A | 3 | RDQ52 | T (LVDS)* | PR60A | 3 | RDQ64 | T (LVDS)* |
| R23 | PR46B | 3 | RLM3_SPLLC_FB_A | C | PR58B | 3 | RLM3_SPLLC_FB_A/RDQ55 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| VCCIO | VCCIO3 | 3 | | | - | - | | |
| R22 | PR46A | 3 | RLM3_SPLLT_FB_A | T | PR58A | 3 | RLM3_SPLLT_FB_A/RDQ55 | T |
| P30 | PR45B | 3 | RLM3_SPLLC_IN_A | C (LVDS)* | PR57B | 3 | RLM3_SPLLC_IN_A/RDQ55 | C (LVDS)* |
| R29 | PR45A | 3 | RLM3_SPLLT_IN_A | T (LVDS)* | PR57A | 3 | RLM3_SPLLT_IN_A/RDQ55 | T (LVDS)* |
| T27 | PR44B | 3 | | C | PR56B | 3 | RDQ55 | C |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| - | - | - | | | VCCIO3 | 3 | | |
| T26 | PR44A | 3 | | T | PR56A | 3 | RDQ55 | T |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| N30 | PR43B | 3 | | C (LVDS)* | PR53B | 3 | RDQ55 | C (LVDS)* |
| N29 | PR43A | 3 | | T (LVDS)* | PR53A | 3 | RDQ55 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| R27 | PR42B | 3 | VREF2_3 | C | PR52B | 3 | VREF2_3/RDQ55 | C |
| R28 | PR42A | 3 | VREF1_3 | T | PR52A | 3 | VREF1_3/RDQ55 | T |
| P29 | PR41B | 3 | PCLKC3_0 | C (LVDS)* | PR51B | 3 | PCLKC3_0/RDQ55 | C (LVDS)* |
| P28 | PR41A | 3 | PCLKT3_0 | T (LVDS)* | PR51A | 3 | PCLKT3_0/RDQ55 | T (LVDS)* |
| M30 | PR39B | 2 | PCLKC2_0/RDQ36 | C | PR49B | 2 | PCLKC2_0/RDQ46 | C |
| M29 | PR39A | 2 | PCLKT2_0/RDQ36 | T | PR49A | 2 | PCLKT2_0/RDQ46 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| P23 | PR38B | 2 | RDQ36 | C (LVDS)* | PR48B | 2 | RDQ46 | C (LVDS)* |
| P24 | PR38A | 2 | RDQ36 | T (LVDS)* | PR48A | 2 | RDQ46 | T (LVDS)* |
| R26 | PR37B | 2 | RDQ36 | C | PR47B | 2 | RDQ46 | C |
| P27 | PR37A | 2 | RDQ36 | T | PR47A | 2 | RDQ46 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| P25 | PR36B | 2 | RDQ36 | C (LVDS)* | PR46B | 2 | RDQ46 | C (LVDS)* |
| P26 | PR36A | 2 | RDQS36 | T (LVDS)* | PR46A | 2 | RDQS46 | T (LVDS)* |
| K30 | PR35B | 2 | RDQ36 | C | PR45B | 2 | RDQ46 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| K29 | PR35A | 2 | RDQ36 | T | PR45A | 2 | RDQ46 | T |
| N22 | PR34B | 2 | RDQ36 | C (LVDS)* | PR44B | 2 | RDQ46 | C (LVDS)* |
| P22 | PR34A | 2 | RDQ36 | T (LVDS)* | PR44A | 2 | RDQ46 | T (LVDS)* |
| J30 | PR33B | 2 | RUM3_SPLLC_FB_A/RDQ36 | C | PR43B | 2 | RUM3_SPLLC_FB_A/RDQ46 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J29 | PR33A | 2 | RUM3_SPLLT_FB_A/RDQ36 | T | PR43A | 2 | RUM3_SPLLT_FB_A/RDQ46 | T |
| N24 | PR32B | 2 | RUM3_SPLLC_IN_A/RDQ36 | C (LVDS)* | PR42B | 2 | RUM3_SPLLC_IN_A/RDQ46 | C (LVDS)* |
| N23 | PR32A | 2 | RUM3_SPLLT_IN_A/RDQ36 | T (LVDS)* | PR42A | 2 | RUM3_SPLLT_IN_A/RDQ46 | T (LVDS)* |
| N25 | PR30B | 2 | RDQ27 | C | PR40B | 2 | RDQ37 | C |
| N26 | PR30A | 2 | RDQ27 | T | PR40A | 2 | RDQ37 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| M27 | PR29B | 2 | RDQ27 | C (LVDS)* | PR39B | 2 | RDQ37 | C (LVDS)* |
| M28 | PR29A | 2 | RDQ27 | T (LVDS)* | PR39A | 2 | RDQ37 | T (LVDS)* |
| H30 | PR28B | 2 | RDQ27 | C | PR38B | 2 | RDQ37 | C |
| G30 | PR28A | 2 | RDQ27 | T | PR38A | 2 | RDQ37 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M25 | PR27B | 2 | RDQ27 | C (LVDS)* | PR37B | 2 | RDQ37 | C (LVDS)* |
| M26 | PR27A | 2 | RDQS27 | T (LVDS)* | PR37A | 2 | RDQS37 | T (LVDS)* |
| L30 | PR26B | 2 | RDQ27 | C | PR36B | 2 | RDQ37 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| L29 | PR26A | 2 | RDQ27 | T | PR36A | 2 | RDQ37 | T |
| L28 | PR25B | 2 | RDQ27 | C (LVDS)* | PR35B | 2 | RDQ37 | C (LVDS)* |
| L27 | PR25A | 2 | RDQ27 | T (LVDS)* | PR35A | 2 | RDQ37 | T (LVDS)* |
| H29 | PR24B | 2 | RDQ27 | C | PR34B | 2 | RDQ37 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| G29 | PR24A | 2 | RDQ27 | T | PR34A | 2 | RDQ37 | T |
| L22 | PR23B | 2 | RDQ27 | C (LVDS)* | PR33B | 2 | RDQ37 | C (LVDS)* |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------|--------------|--|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential | |
| M22 | PR23A | 2 | RDQ27 | T (LVDS)* | PR33A | 2 | RDQ37 | T (LVDS)* | |
| F30 | PR21B | 2 | | C | PR31B | 2 | RDQ28 | C | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| F29 | PR21A | 2 | | T | PR31A | 2 | RDQ28 | T | |
| - | - | - | | | - | - | | | |
| - | - | - | | | - | - | | | |
| E30 | PR20B | 2 | | C (LVDS)* | PR30B | 2 | RDQ28 | C (LVDS)* | |
| E29 | PR20A | 2 | | T (LVDS)* | PR30A | 2 | RDQ28 | T (LVDS)* | |
| VCCIO | VCCIO2 | 2 | | | - | - | | | |
| L25 | PR19B | 2 | | C | PR29B | 2 | RDQ28 | C | |
| L26 | PR19A | 2 | | T | PR29A | 2 | RDQ28 | T | |
| - | - | - | | | VCCIO2 | 2 | | | |
| H28 | PR18B | 2 | | C (LVDS)* | PR28B | 2 | RDQ28 | C (LVDS)* | |
| J28 | PR18A | 2 | | T (LVDS)* | PR28A | 2 | RDQS28 | T (LVDS)* | |
| G28 | PR16B | 2 | | C | PR27B | 2 | RDQ28 | C | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | | |
| G27 | PR16A | 2 | | T | PR27A | 2 | RDQ28 | T | |
| L24 | NC | - | | | PR26B | 2 | RDQ28 | C (LVDS)* | |
| L23 | NC | - | | | PR26A | 2 | RDQ28 | T (LVDS)* | |
| D30 | NC | - | | | PR25B | 2 | RDQ28 | C | |
| - | - | - | | | VCCIO2 | 2 | | | |
| D29 | NC | - | | | PR25A | 2 | RDQ28 | T | |
| K24 | NC | - | | | PR24B | 2 | RDQ28 | C (LVDS)* | |
| K25 | NC | - | | | PR24A | 2 | RDQ28 | T (LVDS)* | |
| J27 | NC | - | | | PR22B | 2 | | C | |
| - | - | - | | | GNDIO2 | - | | | |
| K26 | NC | - | | | PR22A | 2 | | T | |
| K23 | PR15B | 2 | | C (LVDS)* | PR21B | 2 | | C (LVDS)* | |
| K22 | PR15A | 2 | | T (LVDS)* | PR21A | 2 | | T (LVDS)* | |
| J22 | PR14B | 2 | | C | PR20B | 2 | | C | |
| VCCIO | VCCIO2 | - | | | VCCIO2 | 2 | | | |
| J23 | PR14A | 2 | | T | PR20A | 2 | | T | |
| - | - | - | | | GNDIO2 | - | | | |
| - | - | - | | | - | - | | | |
| J26 | NC | - | | | PR17B | 2 | RDQ15 | C (LVDS)* | |
| H26 | NC | - | | | PR17A | 2 | RDQ15 | T (LVDS)* | |
| H27 | NC | - | | | PR16B | 2 | RDQ15 | C | |
| G26 | NC | - | | | PR16A | 2 | RDQ15 | T | |
| - | - | - | | | VCCIO2 | 2 | | | |
| H23 | NC | - | | | PR15B | 2 | RDQ15 | C (LVDS)* | |
| H24 | NC | - | | | PR15A | 2 | RDQS15 | T (LVDS)* | |
| D28 | NC | - | | | PR14B | 2 | RDQ15 | C | |
| - | - | - | | | GNDIO2 | - | | | |
| E28 | NC | - | | | PR14A | 2 | RDQ15 | T | |
| G24 | PR13B | 2 | | C (LVDS)* | PR13B | 2 | RDQ15 | C (LVDS)* | |
| H25 | PR13A | 2 | | T (LVDS)* | PR13A | 2 | RDQ15 | T (LVDS)* | |
| D27 | PR12B | 2 | RUM0_SPLLC_FB_A | C | PR12B | 2 | RUM0_SPLLC_FB_A/RDQ15 | C | |
| GNDIO | GNDIO2 | - | | | VCCIO2 | 2 | | | |
| E27 | PR12A | 2 | RUM0_SPLLT_FB_A | T | PR12A | 2 | RUM0_SPLLT_FB_A/RDQ15 | T | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|-----------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| F26 | PR11B | 2 | RUM0_SPLLC_IN_A | C (LVDS)* | PR11B | 2 | RUM0_SPLLC_IN_A/RDQ15 | C (LVDS)* |
| G25 | PR11A | 2 | RUM0_SPLLT_IN_A | T (LVDS)* | PR11A | 2 | RUM0_SPLLT_IN_A/RDQ15 | T (LVDS)* |
| F24 | PR9B | 2 | VREF2_2 | C | PR9B | 2 | VREF2_2 | C |
| VCCIO | VCCIO2 | - | | | - | - | | |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| F25 | PR9A | 2 | VREF1_2 | T | PR9A | 2 | VREF1_2 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| G23 | XRES | - | | | XRES | 1 | | |
| C30 | URC_SQ_VCCR0 | 12 | | | URC_SQ_VCCR0 | 12 | | |
| A29 | URC_SQ_HDINP0 | 12 | | T | URC_SQ_HDINP0 | 12 | | T |
| B30 | URC_SQ_VCCIB0 | 12 | | | URC_SQ_VCCIB0 | 12 | | |
| B29 | URC_SQ_HDINN0 | 12 | | C | URC_SQ_HDINN0 | 12 | | C |
| C27 | URC_SQ_VCCTX0 | 12 | | | URC_SQ_VCCTX0 | 12 | | |
| A26 | URC_SQ_HDOUTP0 | 12 | | T | URC_SQ_HDOUTP0 | 12 | | T |
| A27 | URC_SQ_VCCOB0 | 12 | | | URC_SQ_VCCOB0 | 12 | | |
| B26 | URC_SQ_HDOUTN0 | 12 | | C | URC_SQ_HDOUTN0 | 12 | | C |
| C26 | URC_SQ_VCCTX1 | 12 | | | URC_SQ_VCCTX1 | 12 | | |
| B25 | URC_SQ_HDOUTN1 | 12 | | C | URC_SQ_HDOUTN1 | 12 | | C |
| C25 | URC_SQ_VCCOB1 | 12 | | | URC_SQ_VCCOB1 | 12 | | |
| A25 | URC_SQ_HDOUTP1 | 12 | | T | URC_SQ_HDOUTP1 | 12 | | T |
| C29 | URC_SQ_VCCR1 | 12 | | | URC_SQ_VCCR1 | 12 | | |
| B28 | URC_SQ_HDINN1 | 12 | | C | URC_SQ_HDINN1 | 12 | | C |
| C28 | URC_SQ_VCCIB1 | 12 | | | URC_SQ_VCCIB1 | 12 | | |
| A28 | URC_SQ_HDINP1 | 12 | | T | URC_SQ_HDINP1 | 12 | | T |
| B24 | URC_SQ_VCCAUX33 | 12 | | | URC_SQ_VCCAUX33 | 12 | | |
| E24 | URC_SQ_REFCLKN | 12 | | C | URC_SQ_REFCLKN | 12 | | C |
| D24 | URC_SQ_REFCLKP | 12 | | T | URC_SQ_REFCLKP | 12 | | T |
| C24 | URC_SQ_VCCP | 12 | | | URC_SQ_VCCP | 12 | | |
| A20 | URC_SQ_HDINP2 | 12 | | T | URC_SQ_HDINP2 | 12 | | T |
| C20 | URC_SQ_VCCIB2 | 12 | | | URC_SQ_VCCIB2 | 12 | | |
| B20 | URC_SQ_HDINN2 | 12 | | C | URC_SQ_HDINN2 | 12 | | C |
| C19 | URC_SQ_VCCR2 | 12 | | | URC_SQ_VCCR2 | 12 | | |
| A23 | URC_SQ_HDOUTP2 | 12 | | T | URC_SQ_HDOUTP2 | 12 | | T |
| C23 | URC_SQ_VCCOB2 | 12 | | | URC_SQ_VCCOB2 | 12 | | |
| B23 | URC_SQ_HDOUTN2 | 12 | | C | URC_SQ_HDOUTN2 | 12 | | C |
| C22 | URC_SQ_VCCTX2 | 12 | | | URC_SQ_VCCTX2 | 12 | | |
| B22 | URC_SQ_HDOUTN3 | 12 | | C | URC_SQ_HDOUTN3 | 12 | | C |
| A21 | URC_SQ_VCCOB3 | 12 | | | URC_SQ_VCCOB3 | 12 | | |
| A22 | URC_SQ_HDOUTP3 | 12 | | T | URC_SQ_HDOUTP3 | 12 | | T |
| C21 | URC_SQ_VCCTX3 | 12 | | | URC_SQ_VCCTX3 | 12 | | |
| B19 | URC_SQ_HDINN3 | 12 | | C | URC_SQ_HDINN3 | 12 | | C |
| B18 | URC_SQ_VCCIB3 | 12 | | | URC_SQ_VCCIB3 | 12 | | |
| A19 | URC_SQ_HDINP3 | 12 | | T | URC_SQ_HDINP3 | 12 | | T |
| C18 | URC_SQ_VCCR3 | 12 | | | URC_SQ_VCCR3 | 12 | | |
| D23 | PT73B | 1 | | C | PT82B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| E21 | PT73A | 1 | | T | PT82A | 1 | | T |
| D26 | PT72B | 1 | | C | PT81B | 1 | | C |
| E26 | PT72A | 1 | | T | PT81A | 1 | | T |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E23 | PT71B | 1 | | C | PT80B | 1 | | C |
| - | - | - | | | VCCIO1 | 1 | | |
| G22 | PT71A | 1 | | T | PT80A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | - | - | | |
| D22 | PT70B | 1 | | C | PT79B | 1 | | C |
| F21 | PT70A | 1 | | T | PT79A | 1 | | T |
| G18 | PT69B | 1 | | C | PT78B | 1 | | C |
| H18 | PT69A | 1 | | T | PT78A | 1 | | T |
| D20 | PT68B | 1 | | C | PT77B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| D21 | PT68A | 1 | | T | PT77A | 1 | | T |
| E20 | PT67B | 1 | | C | PT76B | 1 | | C |
| E19 | PT67A | 1 | | T | PT76A | 1 | | T |
| D19 | PT66B | 1 | | C | PT75B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E18 | PT66A | 1 | | T | PT75A | 1 | | T |
| D18 | PT65B | 1 | | C | PT74B | 1 | | C |
| C17 | PT65A | 1 | | T | PT74A | 1 | | T |
| A17 | PT64B | 1 | | C | PT73B | 1 | | C |
| B17 | PT64A | 1 | | T | PT73A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| J18 | NC | - | | | PT66B | 1 | | C |
| J19 | NC | - | | | PT66A | 1 | | T |
| H17 | NC | - | | | PT65B | 1 | | C |
| J17 | NC | - | | | PT65A | 1 | | T |
| F18 | NC | - | | | PT64B | 1 | | C |
| F17 | NC | - | | | PT64A | 1 | | T |
| - | - | - | | | GNDIO1 | - | | |
| A16 | PT54B | 1 | | C | PT63B | 1 | | C |
| B16 | PT54A | 1 | | T | PT63A | 1 | | T |
| G17 | PT53B | 1 | | C | PT62B | 1 | | C |
| G16 | PT53A | 1 | | T | PT62A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H16 | PT52B | 1 | | C | PT61B | 1 | | C |
| F16 | PT52A | 1 | | T | PT61A | 1 | | T |
| J16 | PT51B | 1 | | C | PT60B | 1 | | C |
| G15 | PT51A | 1 | | T | PT60A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| C16 | PT50B | 1 | | C | PT59B | 1 | | C |
| D16 | PT50A | 1 | | T | PT59A | 1 | | T |
| J15 | PT49B | 1 | | C | PT58B | 1 | | C |
| H15 | PT49A | 1 | | T | PT58A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A15 | PT48B | 1 | VREF2_1 | C | PT57B | 1 | VREF2_1 | C |
| B15 | PT48A | 1 | VREF1_1 | T | PT57A | 1 | VREF1_1 | T |
| F15 | PT47B | 1 | PCLKC1_0 | C | PT56B | 1 | PCLKC1_0 | C |
| E16 | PT47A | 1 | PCLKT1_0 | T | PT56A | 1 | PCLKT1_0 | T |
| C15 | PT46B | 0 | PCLKC0_0 | C | PT55B | 0 | PCLKC0_0 | C |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| D15 | PT46A | 0 | PCLKT0_0 | T | PT55A | 0 | PCLKT0_0 | T |
| C14 | PT45B | 0 | VREF2_0 | C | PT54B | 0 | VREF2_0 | C |
| E15 | PT45A | 0 | VREF1_0 | T | PT54A | 0 | VREF1_0 | T |
| G14 | PT44B | 0 | | C | PT53B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| J14 | PT44A | 0 | | T | PT53A | 0 | | T |
| F14 | PT43B | 0 | | C | PT52B | 0 | | C |
| H14 | PT43A | 0 | | T | PT52A | 0 | | T |
| A14 | PT42B | 0 | | C | PT51B | 0 | | C |
| B14 | PT42A | 0 | | T | PT51A | 0 | | T |
| D13 | PT41B | 0 | | C | PT50B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| F13 | PT41A | 0 | | T | PT50A | 0 | | T |
| G13 | PT40B | 0 | | C | PT49B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| J11 | PT40A | 0 | | T | PT49A | 0 | | T |
| D4 | PT38B | 0 | | C | PT47B | 0 | | C |
| D5 | PT38A | 0 | | T | PT47A | 0 | | T |
| E5 | PT37B | 0 | | C | PT46B | 0 | | C |
| F6 | PT37A | 0 | | T | PT46A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F7 | PT34B | 0 | | C | PT43B | 0 | | C |
| D8 | PT34A | 0 | | T | PT43A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| J13 | PT32B | 0 | | C | PT41B | 0 | | C |
| G11 | PT32A | 0 | | T | PT41A | 0 | | T |
| H13 | PT31B | 0 | | C | PT40B | 0 | | C |
| H12 | PT31A | 0 | | T | PT40A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E8 | PT30B | 0 | | C | PT39B | 0 | | C |
| D9 | PT30A | 0 | | T | PT39A | 0 | | T |
| D12 | PT28B | 0 | | C | PT37B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| E13 | PT28A | 0 | | T | PT37A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| J12 | PT5B | 0 | | C | PT31B | 0 | | C |
| GNDIO | GNDIO0 | - | | | - | - | | |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H10 | PT5A | 0 | | T | PT31A | 0 | | T |
| E12 | PT4B | 0 | | C | PT30B | 0 | | C |
| D11 | PT4A | 0 | | T | PT30A | 0 | | T |
| H11 | PT3B | 0 | | C | PT29B | 0 | | C |
| F11 | PT3A | 0 | | T | PT29A | 0 | | T |
| C13 | VCC | - | | | ULC_SQ_VCCRX0 | 11 | | |
| A12 | PT19A | 0 | | T | ULC_SQ_HDINP0 | 11 | | T |
| B13 | NC | - | | | ULC_SQ_VCCIB0 | 11 | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| B12 | PT19B | 0 | | C | ULC_SQ_HDINN0 | 11 | | C |
| C10 | VCC | - | | | ULC_SQ_VCCTX0 | 11 | | |
| A9 | PT17A | 0 | | T | ULC_SQ_HDOUTP0 | 11 | | T |
| A10 | NC | - | | | ULC_SQ_VCCOB0 | 11 | | |
| B9 | PT17B | 0 | | C | ULC_SQ_HDOUTN0 | 11 | | C |
| C9 | VCC | - | | | ULC_SQ_VCCTX1 | 11 | | |
| B8 | PT18B | 0 | | C | ULC_SQ_HDOUTN1 | 11 | | C |
| C8 | NC | - | | | ULC_SQ_VCCOB1 | 11 | | |
| A8 | PT18A | 0 | | T | ULC_SQ_HDOUTP1 | 11 | | T |
| C12 | VCC | - | | | ULC_SQ_VCCRX1 | 11 | | |
| B11 | PT16B | 0 | | C | ULC_SQ_HDINN1 | 11 | | C |
| C11 | NC | - | | | ULC_SQ_VCCIB1 | 11 | | |
| A11 | PT16A | 0 | | T | ULC_SQ_HDINP1 | 11 | | T |
| B7 | VCCAUX | - | | | ULC_SQ_VCCAUX33 | 11 | | |
| E7 | PT15B | 0 | | C | ULC_SQ_REFCLKN | 11 | | C |
| D7 | PT15A | 0 | | T | ULC_SQ_REFCLKP | 11 | | T |
| C7 | VCC | - | | | ULC_SQ_VCCP | 11 | | |
| A3 | PT12A | 0 | | T | ULC_SQ_HDINP2 | 11 | | T |
| C3 | NC | - | | | ULC_SQ_VCCIB2 | 11 | | |
| B3 | PT12B | 0 | | C | ULC_SQ_HDINN2 | 11 | | C |
| C2 | VCC | - | | | ULC_SQ_VCCRX2 | 11 | | |
| A6 | PT14A | 0 | | T | ULC_SQ_HDOUTP2 | 11 | | T |
| C6 | NC | - | | | ULC_SQ_VCCOB2 | 11 | | |
| B6 | PT14B | 0 | | C | ULC_SQ_HDOUTN2 | 11 | | C |
| C5 | VCC | - | | | ULC_SQ_VCCTX2 | 11 | | |
| B5 | PT13B | 0 | | C | ULC_SQ_HDOUTN3 | 11 | | C |
| A4 | NC | - | | | ULC_SQ_VCCOB3 | 11 | | |
| A5 | PT13A | 0 | | T | ULC_SQ_HDOUTP3 | 11 | | T |
| C4 | VCC | - | | | ULC_SQ_VCCTX3 | 11 | | |
| B2 | PT11B | 0 | | C | ULC_SQ_HDINN3 | 11 | | C |
| B1 | NC | - | | | ULC_SQ_VCCIB3 | 11 | | |
| A2 | PT11A | 0 | | T | ULC_SQ_HDINP3 | 11 | | T |
| C1 | VCC | - | | | ULC_SQ_VCCRX3 | 11 | | |
| L12 | VCC | - | | | VCC | - | | |
| L13 | VCC | - | | | VCC | - | | |
| L18 | VCC | - | | | VCC | - | | |
| L19 | VCC | - | | | VCC | - | | |
| M11 | VCC | - | | | VCC | - | | |
| M12 | VCC | - | | | VCC | - | | |
| M13 | VCC | - | | | VCC | - | | |
| M14 | VCC | - | | | VCC | - | | |
| M15 | VCC | - | | | VCC | - | | |
| M16 | VCC | - | | | VCC | - | | |
| M17 | VCC | - | | | VCC | - | | |
| M18 | VCC | - | | | VCC | - | | |
| M19 | VCC | - | | | VCC | - | | |
| M20 | VCC | - | | | VCC | - | | |
| N11 | VCC | - | | | VCC | - | | |
| N12 | VCC | - | | | VCC | - | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| N19 | VCC | - | | | VCC | - | | |
| N20 | VCC | - | | | VCC | - | | |
| P12 | VCC | - | | | VCC | - | | |
| P19 | VCC | - | | | VCC | - | | |
| R12 | VCC | - | | | VCC | - | | |
| R19 | VCC | - | | | VCC | - | | |
| T12 | VCC | - | | | VCC | - | | |
| T19 | VCC | - | | | VCC | - | | |
| U12 | VCC | - | | | VCC | - | | |
| U19 | VCC | - | | | VCC | - | | |
| V11 | VCC | - | | | VCC | - | | |
| V12 | VCC | - | | | VCC | - | | |
| V19 | VCC | - | | | VCC | - | | |
| V20 | VCC | - | | | VCC | - | | |
| W11 | VCC | - | | | VCC | - | | |
| W12 | VCC | - | | | VCC | - | | |
| W13 | VCC | - | | | VCC | - | | |
| W14 | VCC | - | | | VCC | - | | |
| W15 | VCC | - | | | VCC | - | | |
| W16 | VCC | - | | | VCC | - | | |
| W17 | VCC | - | | | VCC | - | | |
| W18 | VCC | - | | | VCC | - | | |
| W19 | VCC | - | | | VCC | - | | |
| W20 | VCC | - | | | VCC | - | | |
| Y12 | VCC | - | | | VCC | - | | |
| Y13 | VCC | - | | | VCC | - | | |
| Y18 | VCC | - | | | VCC | - | | |
| Y19 | VCC | - | | | VCC | - | | |
| D14 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E6 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E9 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| K12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| K13 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| D17 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E22 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E25 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F19 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| K18 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| K19 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| F28 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J25 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K28 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M21 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M24 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| N21 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| N28 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| P21 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| R25 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AA28 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AB25 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AE28 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| T25 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| U21 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| V21 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| V28 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| W21 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| W24 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AA18 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AA19 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AE19 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AF22 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AG17 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AG25 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AA12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA13 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AE12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AF9 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AG14 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AG6 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AB6 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AE3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| T6 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| U10 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V10 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W10 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| F3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J6 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| N10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| N3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| P10 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| R6 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| AA25 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AD28 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AA10 | VCCAUX | - | | | VCCAUX | - | | |
| AA11 | VCCAUX | - | | | VCCAUX | - | | |
| AA20 | VCCAUX | - | | | VCCAUX | - | | |
| AA21 | VCCAUX | - | | | VCCAUX | - | | |
| K10 | VCCAUX | - | | | VCCAUX | - | | |
| K11 | VCCAUX | - | | | VCCAUX | - | | |
| K20 | VCCAUX | - | | | VCCAUX | - | | |
| K21 | VCCAUX | - | | | VCCAUX | - | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| L10 | VCCAUX | - | | | VCCAUX | - | | |
| L11 | VCCAUX | - | | | VCCAUX | - | | |
| L20 | VCCAUX | - | | | VCCAUX | - | | |
| L21 | VCCAUX | - | | | VCCAUX | - | | |
| Y10 | VCCAUX | - | | | VCCAUX | - | | |
| Y11 | VCCAUX | - | | | VCCAUX | - | | |
| Y20 | VCCAUX | - | | | VCCAUX | - | | |
| Y21 | VCCAUX | - | | | VCCAUX | - | | |
| A1 | GND | - | | | GND | - | | |
| A13 | GND | - | | | GND | - | | |
| A18 | GND | - | | | GND | - | | |
| A24 | GND | - | | | GND | - | | |
| A30 | GND | - | | | GND | - | | |
| A7 | GND | - | | | GND | - | | |
| AA14 | GND | - | | | GND | - | | |
| AA15 | GND | - | | | GND | - | | |
| AA16 | GND | - | | | GND | - | | |
| AA17 | GND | - | | | GND | - | | |
| AA24 | GND | - | | | GND | - | | |
| AA27 | GND | - | | | GND | - | | |
| AA4 | GND | - | | | GND | - | | |
| AB24 | GND | - | | | GND | - | | |
| AB7 | GND | - | | | GND | - | | |
| AD12 | GND | - | | | GND | - | | |
| AD19 | GND | - | | | GND | - | | |
| AD27 | GND | - | | | GND | - | | |
| AE22 | GND | - | | | GND | - | | |
| AE27 | GND | - | | | GND | - | | |
| AE4 | GND | - | | | GND | - | | |
| AE9 | GND | - | | | GND | - | | |
| AF14 | GND | - | | | GND | - | | |
| AF17 | GND | - | | | GND | - | | |
| AF25 | GND | - | | | GND | - | | |
| AF6 | GND | - | | | GND | - | | |
| AJ10 | GND | - | | | GND | - | | |
| AJ21 | GND | - | | | GND | - | | |
| AJ27 | GND | - | | | GND | - | | |
| AJ4 | GND | - | | | GND | - | | |
| AK1 | GND | - | | | GND | - | | |
| AK13 | GND | - | | | GND | - | | |
| AK18 | GND | - | | | GND | - | | |
| AK24 | GND | - | | | GND | - | | |
| AK30 | GND | - | | | GND | - | | |
| AK7 | GND | - | | | GND | - | | |
| B10 | GND | - | | | GND | - | | |
| B21 | GND | - | | | GND | - | | |
| B27 | GND | - | | | GND | - | | |
| B4 | GND | - | | | GND | - | | |
| D25 | GND | - | | | GND | - | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D6 | GND | - | | | GND | - | | |
| E14 | GND | - | | | GND | - | | |
| E17 | GND | - | | | GND | - | | |
| F22 | GND | - | | | GND | - | | |
| F27 | GND | - | | | GND | - | | |
| F4 | GND | - | | | GND | - | | |
| F9 | GND | - | | | GND | - | | |
| G12 | GND | - | | | GND | - | | |
| G19 | GND | - | | | GND | - | | |
| J24 | GND | - | | | GND | - | | |
| J7 | GND | - | | | GND | - | | |
| K14 | GND | - | | | GND | - | | |
| K15 | GND | - | | | GND | - | | |
| K16 | GND | - | | | GND | - | | |
| K17 | GND | - | | | GND | - | | |
| K27 | GND | - | | | GND | - | | |
| K4 | GND | - | | | GND | - | | |
| L14 | GND | - | | | GND | - | | |
| L15 | GND | - | | | GND | - | | |
| L16 | GND | - | | | GND | - | | |
| L17 | GND | - | | | GND | - | | |
| M23 | GND | - | | | GND | - | | |
| M8 | GND | - | | | GND | - | | |
| N14 | GND | - | | | GND | - | | |
| N15 | GND | - | | | GND | - | | |
| N16 | GND | - | | | GND | - | | |
| N17 | GND | - | | | GND | - | | |
| N27 | GND | - | | | GND | - | | |
| N4 | GND | - | | | GND | - | | |
| P11 | GND | - | | | GND | - | | |
| P13 | GND | - | | | GND | - | | |
| P14 | GND | - | | | GND | - | | |
| P15 | GND | - | | | GND | - | | |
| P16 | GND | - | | | GND | - | | |
| P17 | GND | - | | | GND | - | | |
| P18 | GND | - | | | GND | - | | |
| P20 | GND | - | | | GND | - | | |
| R10 | GND | - | | | GND | - | | |
| R11 | GND | - | | | GND | - | | |
| R13 | GND | - | | | GND | - | | |
| R14 | GND | - | | | GND | - | | |
| R15 | GND | - | | | GND | - | | |
| R16 | GND | - | | | GND | - | | |
| R17 | GND | - | | | GND | - | | |
| R18 | GND | - | | | GND | - | | |
| R20 | GND | - | | | GND | - | | |
| R21 | GND | - | | | GND | - | | |
| R24 | GND | - | | | GND | - | | |
| R7 | GND | - | | | GND | - | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| T10 | GND | - | | | GND | - | | |
| T11 | GND | - | | | GND | - | | |
| T13 | GND | - | | | GND | - | | |
| T14 | GND | - | | | GND | - | | |
| T15 | GND | - | | | GND | - | | |
| T16 | GND | - | | | GND | - | | |
| T17 | GND | - | | | GND | - | | |
| T18 | GND | - | | | GND | - | | |
| T20 | GND | - | | | GND | - | | |
| T21 | GND | - | | | GND | - | | |
| T24 | GND | - | | | GND | - | | |
| T7 | GND | - | | | GND | - | | |
| U11 | GND | - | | | GND | - | | |
| U13 | GND | - | | | GND | - | | |
| U14 | GND | - | | | GND | - | | |
| U15 | GND | - | | | GND | - | | |
| U16 | GND | - | | | GND | - | | |
| U17 | GND | - | | | GND | - | | |
| U18 | GND | - | | | GND | - | | |
| U20 | GND | - | | | GND | - | | |
| V14 | GND | - | | | GND | - | | |
| V15 | GND | - | | | GND | - | | |
| V16 | GND | - | | | GND | - | | |
| V17 | GND | - | | | GND | - | | |
| V27 | GND | - | | | GND | - | | |
| V4 | GND | - | | | GND | - | | |
| W23 | GND | - | | | GND | - | | |
| W8 | GND | - | | | GND | - | | |
| Y14 | GND | - | | | GND | - | | |
| Y15 | GND | - | | | GND | - | | |
| Y16 | GND | - | | | GND | - | | |
| Y17 | GND | - | | | GND | - | | |
| AA26 | NC | - | | | NC | - | | |
| AB10 | PL73B | 6 | LDQ71 | C (LVDS)* | NC | - | | |
| AB11 | NC | - | | | NC | - | | |
| AB12 | NC | - | | | NC | - | | |
| AB13 | NC | - | | | NC | - | | |
| AB14 | NC | - | | | NC | - | | |
| AB15 | NC | - | | | NC | - | | |
| AB16 | NC | - | | | NC | - | | |
| AB17 | NC | - | | | NC | - | | |
| AB19 | NC | - | | | NC | - | | |
| AB20 | NC | - | | | NC | - | | |
| AB21 | NC | - | | | NC | - | | |
| AB9 | PL73A | 6 | LDQ71 | T (LVDS)* | NC | - | | |
| AC10 | PL74B | 6 | LDQ71 | C | NC | - | | |
| AC11 | NC | - | | | NC | - | | |
| AC21 | NC | - | | | NC | - | | |
| AC22 | NC | - | | | NC | - | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AC8 | PL70B | 6 | LDQ71 | C | NC | - | | |
| AC9 | PL74A | 6 | LDQ71 | T | NC | - | | |
| AD21 | NC | - | | | NC | - | | |
| AD22 | NC | - | | | NC | - | | |
| AD4 | PL68A | 6 | LDQ71 | T | NC | - | | |
| AD5 | PL68B | 6 | LDQ71 | C | NC | - | | |
| AD6 | PL71A | 6 | LDQS71 | T (LVDS)* | NC | - | | |
| AD7 | PL72A | 6 | LDQ71 | T | NC | - | | |
| AD8 | PL72B | 6 | LDQ71 | C | NC | - | | |
| AE23 | NC | - | | | NC | - | | |
| AE5 | PL69A | 6 | LDQ71 | T (LVDS)* | NC | - | | |
| AE6 | PL70A | 6 | LDQ71 | T | NC | - | | |
| AE7 | PL71B | 6 | LDQ71 | C (LVDS)* | NC | - | | |
| AF20 | NC | - | | | NC | - | | |
| AF23 | NC | - | | | NC | - | | |
| AF5 | PL69B | 6 | LDQ71 | C (LVDS)* | NC | - | | |
| AG23 | NC | - | | | NC | - | | |
| AG26 | NC | - | | | NC | - | | |
| D10 | PT10A | 0 | | T | NC | - | | |
| E10 | PT9B | 0 | | C | NC | - | | |
| E11 | PT10B | 0 | | C | NC | - | | |
| F10 | PT9A | 0 | | T | NC | - | | |
| F20 | NC | - | | | NC | - | | |
| F23 | NC | - | | | NC | - | | |
| F8 | PL6B | 7 | LDQ6 | C (LVDS)* | NC | - | | |
| G10 | NC | - | | | NC | - | | |
| G20 | NC | - | | | NC | - | | |
| G21 | NC | - | | | NC | - | | |
| G7 | PL8A | 7 | LDQ6 | T (LVDS)* | NC | - | | |
| G8 | PL6A | 7 | LDQS6**** | T (LVDS)* | NC | - | | |
| G9 | PL5A | 7 | LDQ6 | T | NC | - | | |
| H19 | NC | - | | | NC | - | | |
| H20 | NC | - | | | NC | - | | |
| H21 | NC | - | | | NC | - | | |
| H22 | NC | - | | | NC | - | | |
| H6 | PL8B | 7 | LDQ6 | C (LVDS)* | NC | - | | |
| H8 | PL5B | 7 | LDQ6 | C | NC | - | | |
| H9 | PL2A | 7 | LDQ6 | T (LVDS)* | NC | - | | |
| J10 | PL2B | 7 | LDQ6 | C (LVDS)* | NC | - | | |
| J20 | NC | - | | | NC | - | | |
| J21 | NC | - | | | NC | - | | |
| J9 | PL4A | 7 | LDQ6 | T (LVDS)* | NC | - | | |
| K9 | PL4B | 7 | LDQ6 | C (LVDS)* | NC | - | | |
| R9 | NC | - | | | NC | - | | |
| U22 | NC | - | | | NC | - | | |
| W9 | NC | - | | | NC | - | | |
| N13 | VCCPLL | - | | | VCCPLL | - | | |
| N18 | VCCPLL | - | | | VCCPLL | - | | |
| V13 | VCCPLL | - | | | VCCPLL | - | | |

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

| LFE2M50E/SE | | | | | LFE2M70E/SE | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| V18 | VCCPLL | - | | | VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M100E/SE Logic Signal Connections: 900 fpBGA

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| D2 | PL9A | 7 | VREF2_7 | T |
| D3 | PL9B | 7 | VREF1_7 | C |
| GNDIO | GNDIO7 | - | | |
| J8 | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* |
| H7 | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C (LVDS)* |
| E3 | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T |
| E4 | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C |
| G6 | PL13A | 7 | LDQ15 | T (LVDS)* |
| F5 | PL13B | 7 | LDQ15 | C (LVDS)* |
| E2 | PL14A | 7 | LDQ15 | T |
| D1 | PL14B | 7 | LDQ15 | C |
| GNDIO | GNDIO7 | - | | |
| G5 | PL15A | 7 | LDQS15 | T (LVDS)* |
| G4 | PL15B | 7 | LDQ15 | C (LVDS)* |
| K7 | PL16A | 7 | LDQ15 | T |
| K8 | PL16B | 7 | LDQ15 | C |
| E1 | PL17A | 7 | LDQ15 | T (LVDS)* |
| F2 | PL17B | 7 | LDQ15 | C (LVDS)* |
| F1 | PL18A | 7 | LDQ15 | T |
| GNDIO | GNDIO7 | - | | |
| G3 | PL18B | 7 | LDQ15 | C |
| GNDIO | GNDIO7 | - | | |
| H5 | PL25A | 7 | LDQ23 | T (LVDS)* |
| H4 | PL25B | 7 | LDQ23 | C (LVDS)* |
| J5 | PL26A | 7 | LDQ23 | T |
| J4 | PL26B | 7 | LDQ23 | C |
| GNDIO | GNDIO7 | - | | |
| G2 | PL28A | 7 | LDQ32 | T (LVDS)* |
| G1 | PL28B | 7 | LDQ32 | C (LVDS)* |
| L9 | PL29A | 7 | LDQ32 | T |
| L7 | PL29B | 7 | LDQ32 | C |
| K6 | PL30A | 7 | LDQ32 | T (LVDS)* |
| K5 | PL30B | 7 | LDQ32 | C (LVDS)* |
| L8 | PL31A | 7 | LDQ32 | T |
| L6 | PL31B | 7 | LDQ32 | C |
| GNDIO | GNDIO7 | - | | |
| H3 | PL32A | 7 | LDQS32 | T (LVDS)* |
| H2 | PL32B | 7 | LDQ32 | C (LVDS)* |
| N8 | PL33A | 7 | LDQ32 | T |
| M9 | PL33B | 7 | LDQ32 | C |
| J3 | PL34A | 7 | LDQ32 | T (LVDS)* |
| - | - | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| J2 | PL34B | 7 | LDQ32 | C (LVDS)* |
| H1 | PL35A | 7 | LDQ32 | T |
| GNDIO | GNDIO7 | - | | |
| J1 | PL35B | 7 | LDQ32 | C |
| GNDIO | GNDIO7 | - | | |
| L5 | PL41A | 7 | LDQ45 | T (LVDS)* |
| L4 | PL41B | 7 | LDQ45 | C (LVDS)* |
| N9 | PL42A | 7 | LDQ45 | T |
| N7 | PL42B | 7 | LDQ45 | C |
| K2 | PL43A | 7 | LDQ45 | T (LVDS)* |
| K1 | PL43B | 7 | LDQ45 | C (LVDS)* |
| P9 | PL44A | 7 | LDQ45 | T |
| P7 | PL44B | 7 | LDQ45 | C |
| GNDIO | GNDIO7 | - | | |
| M6 | PL45A | 7 | LDQS45 | T (LVDS)* |
| M5 | PL45B | 7 | LDQ45 | C (LVDS)* |
| N5 | PL46A | 7 | LDQ45 | T |
| N6 | PL46B | 7 | LDQ45 | C |
| M4 | PL47A | 7 | LDQ45 | T (LVDS)* |
| M3 | PL47B | 7 | LDQ45 | C (LVDS)* |
| P6 | PL48A | 7 | LDQ45 | T |
| GNDIO | GNDIO7 | - | | |
| P8 | PL48B | 7 | LDQ45 | C |
| L3 | PL50A | 7 | LUM3_SPLLT_IN_A/LDQ54 | T (LVDS)* |
| L2 | PL50B | 7 | LUM3_SPLLC_IN_A/LDQ54 | C (LVDS)* |
| P5 | PL51A | 7 | LUM3_SPLLT_FB_A/LDQ54 | T |
| P4 | PL51B | 7 | LUM3_SPLLC_FB_A/LDQ54 | C |
| L1 | PL52A | 7 | LDQ54 | T (LVDS)* |
| M2 | PL52B | 7 | LDQ54 | C (LVDS)* |
| R5 | PL53A | 7 | LDQ54 | T |
| R4 | PL53B | 7 | LDQ54 | C |
| GNDIO | GNDIO7 | - | | |
| M1 | PL54A | 7 | LDQS54 | T (LVDS)* |
| N2 | PL54B | 7 | LDQ54 | C (LVDS)* |
| R8 | PL55A | 7 | LDQ54 | T |
| T9 | PL55B | 7 | LDQ54 | C |
| P3 | PL56A | 7 | LDQ54 | T (LVDS)* |
| P2 | PL56B | 7 | LDQ54 | C (LVDS)* |
| N1 | PL57A | 7 | PCLKT7_0/LDQ54 | T |
| GNDIO | GNDIO7 | - | | |
| P1 | PL57B | 7 | PCLKC7_0/LDQ54 | C |
| T5 | PL59A | 6 | PCLKT6_0/LDQ63 | T (LVDS)* |
| T4 | PL59B | 6 | PCLKC6_0/LDQ63 | C (LVDS)* |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| U7 | PL60A | 6 | VREF2_6/LDQ63 | T |
| T8 | PL60B | 6 | VREF1_6/LDQ63 | C |
| R3 | PL61A | 6 | LDQ63 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | |
| R2 | PL61B | 6 | LDQ63 | C (LVDS)* |
| R1 | PL62A | 6 | LDQ63 | T |
| T1 | PL62B | 6 | LDQ63 | C |
| GNDIO | GNDIO6 | - | | |
| VCCIO | VCCIO6 | 6 | | |
| T3 | PL65A | 6 | LLM4_SPLLT_IN_A/LDQ63 | T (LVDS)* |
| T2 | PL65B | 6 | LLM4_SPLLC_IN_A/LDQ63 | C (LVDS)* |
| U9 | PL66A | 6 | LLM4_SPLLT_FB_A/LDQ63 | T |
| U8 | PL66B | 6 | LLM4_SPLLC_FB_A/LDQ63 | C |
| GNDIO | GNDIO6 | - | | |
| U5 | PL68A | 6 | LDQ72 | T (LVDS)* |
| U4 | PL68B | 6 | LDQ72 | C (LVDS)* |
| V9 | PL69A | 6 | LDQ72 | T |
| V7 | PL69B | 6 | LDQ72 | C |
| VCCIO | VCCIO6 | 6 | | |
| U3 | PL70A | 6 | LDQ72 | T (LVDS)* |
| U2 | PL70B | 6 | LDQ72 | C (LVDS)* |
| V8 | PL71A | 6 | LDQ72 | T |
| U6 | PL71B | 6 | LDQ72 | C |
| GNDIO | GNDIO6 | - | | |
| U1 | PL72A | 6 | LDQS72 | T (LVDS)* |
| V2 | PL72B | 6 | LDQ72 | C (LVDS)* |
| V5 | PL73A | 6 | LDQ72 | T |
| VCCIO | VCCIO6 | 6 | | |
| V6 | PL73B | 6 | LDQ72 | C |
| V1 | PL74A | 6 | LDQ72 | T (LVDS)* |
| W1 | PL74B | 6 | LDQ72 | C (LVDS)* |
| W5 | PL75A | 6 | LDQ72 | T |
| GNDIO | GNDIO6 | - | | |
| W6 | PL75B | 6 | LDQ72 | C |
| W3 | PL77A | 6 | LDQ81 | T (LVDS)* |
| W4 | PL77B | 6 | LDQ81 | C (LVDS)* |
| W2 | PL78A | 6 | LDQ81 | T |
| Y4 | PL78B | 6 | LDQ81 | C |
| Y1 | PL79A | 6 | LDQ81 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | |
| Y2 | PL79B | 6 | LDQ81 | C (LVDS)* |
| Y5 | PL80A | 6 | LDQ81 | T |
| Y6 | PL80B | 6 | LDQ81 | C |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|--------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AA1 | PL81A | 6 | LDQS81 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | |
| AA2 | PL81B | 6 | LDQ81 | C (LVDS)* |
| Y3 | PL82A | 6 | LDQ81 | T |
| AB1 | PL82B | 6 | LDQ81 | C |
| VCCIO | VCCIO6 | 6 | | |
| Y9 | PL83A | 6 | LDQ81 | T (LVDS)* |
| Y8 | PL83B | 6 | LDQ81 | C (LVDS)* |
| Y7 | PL84A | 6 | LDQ81 | T |
| AA7 | PL84B | 6 | LDQ81 | C |
| GNDIO | GNDIO6 | - | | |
| VCCIO | VCCIO6 | 6 | | |
| AB2 | PL95A | 6 | LDQ99 | T (LVDS)* |
| AB3 | PL95B | 6 | LDQ99 | C (LVDS)* |
| AA5 | PL96A | 6 | LDQ99 | T |
| AA6 | PL96B | 6 | LDQ99 | C |
| AB4 | PL97A | 6 | LDQ99 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | |
| AB5 | PL97B | 6 | LDQ99 | C (LVDS)* |
| AA8 | PL98A | 6 | LDQ99 | T |
| AA9 | PL98B | 6 | LDQ99 | C |
| AC1 | PL99A | 6 | LLM0_GPLLT_IN_A**/LDQS99 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | |
| AC2 | PL99B | 6 | LLM0_GPLLC_IN_A**/LDQ99 | C (LVDS)* |
| AC4 | PL100A | 6 | LLM0_GPLLT_FB_A/LDQ99 | T |
| AC3 | PL100B | 6 | LLM0_GPLLC_FB_A/LDQ99 | C |
| VCCIO | VCCIO6 | 6 | | |
| AC7 | PL101A | 6 | LLM0_GDLLT_IN_A**/LDQ99 | T (LVDS)* |
| AC6 | PL101B | 6 | LLM0_GDLLC_IN_A**/LDQ99 | C (LVDS)* |
| AC5 | PL102A | 6 | LLM0_GDLLT_FB_A/LDQ99 | T |
| AD3 | PL102B | 6 | LLM0_GDLLC_FB_A/LDQ99 | C |
| GNDIO | GNDIO6 | - | | |
| AB8 | LLM0_PLLCAP | 6 | | |
| AD2 | PL104A | 6 | | T |
| AD1 | PL104B | 6 | | C |
| AE2 | TCK | - | | |
| AE1 | TDI | - | | |
| AF2 | TMS | - | | |
| AF1 | TDO | - | | |
| AG1 | VCCJ | - | | |
| AH1 | LLC_SQ_VCCR3 | 14 | | |
| AK2 | LLC_SQ_HDINP3 | 14 | | T |
| AJ1 | LLC_SQ_VCCIB3 | 14 | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AJ2 | LLC_SQ_HDINN3 | 14 | | C |
| AH4 | LLC_SQ_VCCTX3 | 14 | | |
| AK5 | LLC_SQ_HDOUTP3 | 14 | | T |
| AK4 | LLC_SQ_VCCOB3 | 14 | | |
| AJ5 | LLC_SQ_HDOUTN3 | 14 | | C |
| AH5 | LLC_SQ_VCCTX2 | 14 | | |
| AJ6 | LLC_SQ_HDOUTN2 | 14 | | C |
| AH6 | LLC_SQ_VCCOB2 | 14 | | |
| AK6 | LLC_SQ_HDOUTP2 | 14 | | T |
| AH2 | LLC_SQ_VCCR2 | 14 | | |
| AJ3 | LLC_SQ_HDINN2 | 14 | | C |
| AH3 | LLC_SQ_VCCIB2 | 14 | | |
| AK3 | LLC_SQ_HDINP2 | 14 | | T |
| AH7 | LLC_SQ_VCCP | 14 | | |
| AG7 | LLC_SQ_REFCLKP | 14 | | T |
| AF7 | LLC_SQ_REFCLKN | 14 | | C |
| AJ7 | LLC_SQ_VCCAUX33 | 14 | | |
| AK11 | LLC_SQ_HDINP1 | 14 | | T |
| AH11 | LLC_SQ_VCCIB1 | 14 | | |
| AJ11 | LLC_SQ_HDINN1 | 14 | | C |
| AH12 | LLC_SQ_VCCR1 | 14 | | |
| AK8 | LLC_SQ_HDOUTP1 | 14 | | T |
| AH8 | LLC_SQ_VCCOB1 | 14 | | |
| AJ8 | LLC_SQ_HDOUTN1 | 14 | | C |
| AH9 | LLC_SQ_VCCTX1 | 14 | | |
| AJ9 | LLC_SQ_HDOUTN0 | 14 | | C |
| AK10 | LLC_SQ_VCCOB0 | 14 | | |
| AK9 | LLC_SQ_HDOUTP0 | 14 | | T |
| AH10 | LLC_SQ_VCCTX0 | 14 | | |
| AJ12 | LLC_SQ_HDINN0 | 14 | | C |
| AJ13 | LLC_SQ_VCCIB0 | 14 | | |
| AK12 | LLC_SQ_HDINP0 | 14 | | T |
| AH13 | LLC_SQ_VCCR0 | 14 | | |
| AF10 | PB30A | 5 | BDQ33 | T |
| AE8 | PB30B | 5 | BDQ33 | C |
| AE11 | PB31A | 5 | BDQ33 | T |
| VCCIO | VCCIO5 | 5 | | |
| AD9 | PB31B | 5 | BDQ33 | C |
| AE10 | PB32A | 5 | BDQ33 | T |
| AD10 | PB32B | 5 | BDQ33 | C |
| AE13 | PB33A | 5 | BDQS33 | T |
| GNDIO | GNDIO5 | - | | |
| AC12 | PB33B | 5 | BDQ33 | C |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AG2 | PB34A | 5 | BDQ33 | T |
| AG3 | PB34B | 5 | BDQ33 | C |
| AD13 | PB35A | 5 | BDQ33 | T |
| VCCIO | VCCIO5 | 5 | | |
| AC13 | PB35B | 5 | BDQ33 | C |
| AE14 | PB36A | 5 | BDQ33 | T |
| AC14 | PB36B | 5 | BDQ33 | C |
| AF3 | PB37A | 5 | BDQ33 | T |
| GNDIO | GNDIO5 | - | | |
| AF4 | PB37B | 5 | BDQ33 | C |
| - | - | - | | |
| AG4 | PB38A | 5 | BDQ42 | T |
| AG5 | PB38B | 5 | BDQ42 | C |
| GNDIO | GNDIO5 | - | | |
| - | - | - | | |
| AD11 | PB48A | 5 | BDQ51 | T |
| AF13 | PB48B | 5 | BDQ51 | C |
| AF12 | PB49A | 5 | BDQ51 | T |
| VCCIO | VCCIO5 | 5 | | |
| AD14 | PB49B | 5 | BDQ51 | C |
| AG8 | PB50A | 5 | BDQ51 | T |
| AF8 | PB50B | 5 | BDQ51 | C |
| AE15 | PB51A | 5 | BDQS51**** | T |
| GNDIO | GNDIO5 | - | | |
| - | - | - | | |
| AC15 | PB51B | 5 | BDQ51 | C |
| VCCIO | VCCIO5 | 5 | | |
| GNDIO | GNDIO5 | - | | |
| AD15 | PB56A | 5 | BDQ60 | T |
| AF15 | PB56B | 5 | BDQ60 | C |
| AG10 | PB57A | 5 | BDQ60 | T |
| AG9 | PB57B | 5 | BDQ60 | C |
| AH14 | PB58A | 5 | BDQ60 | T |
| AG12 | PB58B | 5 | BDQ60 | C |
| VCCIO | VCCIO5 | 5 | | |
| AG15 | PB59A | 5 | BDQ60 | T |
| AG13 | PB59B | 5 | BDQ60 | C |
| GNDIO | GNDIO5 | - | | |
| AF16 | PB60A | 5 | BDQS60 | T |
| AH15 | PB60B | 5 | BDQ60 | C |
| AC16 | PB61A | 5 | VREF2_5/BDQ60 | T |
| AE16 | PB61B | 5 | VREF1_5/BDQ60 | C |
| AG11 | PB62A | 5 | PCLKT5_0/BDQ60 | T |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AF11 | PB62B | 5 | PCLKC5_0/BDQ60 | C |
| VCCIO | VCCIO5 | 5 | | |
| GNDIO | GNDIO5 | - | | |
| AJ14 | PB67A | 4 | PCLKT4_0/BDQ69 | T |
| VCCIO | VCCIO4 | 4 | | |
| AK14 | PB67B | 4 | PCLKC4_0/BDQ69 | C |
| AK15 | PB68A | 4 | VREF2_4/BDQ69 | T |
| AK16 | PB68B | 4 | VREF1_4/BDQ69 | C |
| AF18 | PB69A | 4 | BDQS69 | T |
| GNDIO | GNDIO4 | - | | |
| AD16 | PB69B | 4 | BDQ69 | C |
| AJ15 | PB70A | 4 | BDQ69 | T |
| AG16 | PB70B | 4 | BDQ69 | C |
| AE17 | PB71A | 4 | BDQ69 | T |
| VCCIO | VCCIO4 | 4 | | |
| AC17 | PB71B | 4 | BDQ69 | C |
| AH16 | PB72A | 4 | BDQ69 | T |
| AK17 | PB72B | 4 | BDQ69 | C |
| AG20 | PB73A | 4 | BDQ69 | T |
| GNDIO | GNDIO4 | - | | |
| AG21 | PB73B | 4 | BDQ69 | C |
| AG18 | PB74A | 4 | BDQ78 | T |
| AJ16 | PB74B | 4 | BDQ78 | C |
| AF21 | PB75A | 4 | BDQ78 | T |
| AG22 | PB75B | 4 | BDQ78 | C |
| AD17 | PB76A | 4 | BDQ78 | T |
| AF19 | PB76B | 4 | BDQ78 | C |
| VCCIO | VCCIO4 | 4 | | |
| GNDIO | GNDIO4 | - | | |
| AH17 | PB80A | 4 | BDQ78 | T |
| AJ17 | PB80B | 4 | BDQ78 | C |
| VCCIO | VCCIO4 | 4 | | |
| AF26 | PB82A | 4 | BDQ78 | T |
| AE25 | PB82B | 4 | BDQ78 | C |
| GNDIO | GNDIO4 | - | | |
| AD24 | PB92A | 4 | BDQ96 | T |
| AE24 | PB92B | 4 | BDQ96 | C |
| AD18 | PB93A | 4 | BDQ96 | T |
| AC18 | PB93B | 4 | BDQ96 | C |
| AE18 | PB94A | 4 | BDQ96 | T |
| AG19 | PB94B | 4 | BDQ96 | C |
| VCCIO | VCCIO4 | 4 | | |
| GNDIO | GNDIO4 | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AC19 | PB96A | 4 | BDQS96 | T |
| AD20 | PB96B | 4 | BDQ96 | C |
| AB18 | PB97A | 4 | BDQ96 | T |
| AC20 | PB97B | 4 | BDQ96 | C |
| AE20 | PB98A | 4 | BDQ96 | T |
| AE21 | PB98B | 4 | BDQ96 | C |
| VCCIO | VCCIO4 | 4 | | |
| AC23 | PB99A | 4 | BDQ96 | T |
| AD23 | PB99B | 4 | BDQ96 | C |
| GNDIO | GNDIO4 | - | | |
| AH18 | LRC_SQ_VCCR3 | 13 | | |
| AK19 | LRC_SQ_HDINP3 | 13 | | T |
| AJ18 | LRC_SQ_VCCIB3 | 13 | | |
| AJ19 | LRC_SQ_HDINN3 | 13 | | C |
| AH21 | LRC_SQ_VCCTX3 | 13 | | |
| AK22 | LRC_SQ_HDOUTP3 | 13 | | T |
| AK21 | LRC_SQ_VCCOB3 | 13 | | |
| AJ22 | LRC_SQ_HDOUTN3 | 13 | | C |
| AH22 | LRC_SQ_VCCTX2 | 13 | | |
| AJ23 | LRC_SQ_HDOUTN2 | 13 | | C |
| AH23 | LRC_SQ_VCCOB2 | 13 | | |
| AK23 | LRC_SQ_HDOUTP2 | 13 | | T |
| AH19 | LRC_SQ_VCCR2 | 13 | | |
| AJ20 | LRC_SQ_HDINN2 | 13 | | C |
| AH20 | LRC_SQ_VCCIB2 | 13 | | |
| AK20 | LRC_SQ_HDINP2 | 13 | | T |
| AH24 | LRC_SQ_VCCP | 13 | | |
| AG24 | LRC_SQ_REFCLKP | 13 | | T |
| AF24 | LRC_SQ_REFCLKN | 13 | | C |
| AJ24 | LRC_SQ_VCCAUX33 | 13 | | |
| AK28 | LRC_SQ_HDINP1 | 13 | | T |
| AH28 | LRC_SQ_VCCIB1 | 13 | | |
| AJ28 | LRC_SQ_HDINN1 | 13 | | C |
| AH29 | LRC_SQ_VCCR1 | 13 | | |
| AK25 | LRC_SQ_HDOUTP1 | 13 | | T |
| AH25 | LRC_SQ_VCCOB1 | 13 | | |
| AJ25 | LRC_SQ_HDOUTN1 | 13 | | C |
| AH26 | LRC_SQ_VCCTX1 | 13 | | |
| AJ26 | LRC_SQ_HDOUTN0 | 13 | | C |
| AK27 | LRC_SQ_VCCOB0 | 13 | | |
| AK26 | LRC_SQ_HDOUTP0 | 13 | | T |
| AH27 | LRC_SQ_VCCTX0 | 13 | | |
| AJ29 | LRC_SQ_HDINN0 | 13 | | C |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|----------------------|------|-------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AJ30 | LRC_SQ_VCCIB0 | 13 | | |
| AK29 | LRC_SQ_HDINP0 | 13 | | T |
| AH30 | LRC_SQ_VCCRX0 | 13 | | |
| AG27 | CFG2 | 8 | | |
| AD25 | CFG1 | 8 | | |
| AG28 | CFG0 | 8 | | |
| AG30 | PROGRAMN | 8 | | |
| AG29 | CCLK | 8 | | |
| AC24 | INITN | 8 | | |
| AF27 | DONE | 8 | | |
| GNDIO | GNDIO8 | - | | |
| AF28 | WRITEN*** | 8 | | |
| AE26 | CS1N*** | 8 | | |
| AB23 | CSN*** | 8 | | |
| AF29 | D0/SPIFASTN*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | |
| AF30 | D1*** | 8 | | |
| AD26 | D2*** | 8 | | |
| AE29 | D3*** | 8 | | |
| GNDIO | GNDIO8 | - | | |
| AE30 | D4*** | 8 | | |
| AD29 | D5*** | 8 | | |
| AC25 | D6*** | 8 | | |
| AD30 | D7/SPID0*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | |
| AA22 | DI/CSSPI0N*** | 8 | | |
| AC26 | DOUT/CSON/CSSPI1N*** | 8 | | |
| AA23 | BUSY/SISPI*** | 8 | | |
| AB22 | RLM0_PLLCAP | 3 | | |
| AC27 | PR102B | 3 | RLM0_GDLLC_FB_A/RDQ99 | C |
| GNDIO | GNDIO3 | - | | |
| AC28 | PR102A | 3 | RLM0_GDLLT_FB_A/RDQ99 | T |
| AC29 | PR101B | 3 | RLM0_GDLLC_IN_A**/RDQ99 | C (LVDS)* |
| AC30 | PR101A | 3 | RLM0_GDLLT_IN_A**/RDQ99 | T (LVDS)* |
| AB30 | PR100B | 3 | RLM0_GPLLC_IN_A**/RDQ99 | C |
| VCCIO | VCCIO3 | 3 | | |
| AA30 | PR100A | 3 | RLM0_GPLLT_IN_A**/RDQ99 | T |
| AB29 | PR99B | 3 | RLM0_GPLLC_FB_A/RDQ99 | C (LVDS)* |
| AB28 | PR99A | 3 | RLM0_GPLLT_FB_A/RDQS99 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | |
| Y22 | PR98B | 3 | RDQ99 | C |
| Y23 | PR98A | 3 | RDQ99 | T |
| AB26 | PR97B | 3 | RDQ99 | C (LVDS)* |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AB27 | PR97A | 3 | RDQ99 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | |
| Y24 | PR96B | 3 | RDQ99 | C |
| Y25 | PR96A | 3 | RDQ99 | T |
| AA29 | PR95B | 3 | RDQ99 | C (LVDS)* |
| Y28 | PR95A | 3 | RDQ99 | T (LVDS)* |
| Y30 | PR93B | 3 | RDQ90 | C |
| Y29 | PR93A | 3 | RDQ90 | T |
| GNDIO | GNDIO3 | - | | |
| VCCIO | VCCIO3 | 3 | | |
| W22 | PR83B | 3 | RDQ81 | C (LVDS)* |
| V22 | PR83A | 3 | RDQ81 | T (LVDS)* |
| Y27 | PR82B | 3 | RDQ81 | C |
| VCCIO | VCCIO3 | 3 | | |
| Y26 | PR82A | 3 | RDQ81 | T |
| W30 | PR81B | 3 | RDQ81 | C (LVDS)* |
| W29 | PR81A | 3 | RDQS81 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | |
| W25 | PR80B | 3 | RDQ81 | C |
| W26 | PR80A | 3 | RDQ81 | T |
| U29 | PR79B | 3 | RDQ81 | C (LVDS)* |
| V29 | PR79A | 3 | RDQ81 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | |
| V30 | PR78B | 3 | RDQ81 | C |
| U30 | PR78A | 3 | RDQ81 | T |
| W27 | PR77B | 3 | RDQ81 | C (LVDS)* |
| W28 | PR77A | 3 | RDQ81 | T (LVDS)* |
| V24 | PR75B | 3 | RDQ72 | C |
| V25 | PR75A | 3 | RDQ72 | T |
| GNDIO | GNDIO3 | - | | |
| U28 | PR74B | 3 | RDQ72 | C (LVDS)* |
| U27 | PR74A | 3 | RDQ72 | T (LVDS)* |
| U23 | PR73B | 3 | RDQ72 | C |
| V23 | PR73A | 3 | RDQ72 | T |
| VCCIO | VCCIO3 | 3 | | |
| V26 | PR72B | 3 | RDQ72 | C (LVDS)* |
| U26 | PR72A | 3 | RDQS72 | T (LVDS)* |
| U25 | PR71B | 3 | RDQ72 | C |
| GNDIO | GNDIO3 | - | | |
| U24 | PR71A | 3 | RDQ72 | T |
| T30 | PR70B | 3 | RDQ72 | C (LVDS)* |
| R30 | PR70A | 3 | RDQ72 | T (LVDS)* |
| T23 | PR69B | 3 | RDQ72 | C |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO3 | 3 | | |
| T22 | PR69A | 3 | RDQ72 | T |
| T29 | PR68B | 3 | RDQ72 | C (LVDS)* |
| T28 | PR68A | 3 | RDQ72 | T (LVDS)* |
| R23 | PR66B | 3 | RLM4_SPLLC_FB_A/RDQ63 | C |
| GNDIO | GNDIO3 | - | | |
| - | - | - | | |
| R22 | PR66A | 3 | RLM4_SPLLT_FB_A/RDQ63 | T |
| P30 | PR65B | 3 | RLM4_SPLLC_IN_A/RDQ63 | C (LVDS)* |
| R29 | PR65A | 3 | RLM4_SPLLT_IN_A/RDQ63 | T (LVDS)* |
| T27 | PR64B | 3 | RDQ63 | C |
| VCCIO | VCCIO3 | 3 | | |
| T26 | PR64A | 3 | RDQ63 | T |
| GNDIO | GNDIO3 | - | | |
| N30 | PR61B | 3 | RDQ63 | C (LVDS)* |
| N29 | PR61A | 3 | RDQ63 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | |
| R27 | PR60B | 3 | VREF2_3/RDQ63 | C |
| R28 | PR60A | 3 | VREF1_3/RDQ63 | T |
| P29 | PR59B | 3 | PCLKC3_0/RDQ63 | C (LVDS)* |
| P28 | PR59A | 3 | PCLKT3_0/RDQ63 | T (LVDS)* |
| M30 | PR57B | 2 | PCLKC2_0/RDQ54 | C |
| M29 | PR57A | 2 | PCLKT2_0/RDQ54 | T |
| GNDIO | GNDIO2 | - | | |
| P23 | PR56B | 2 | RDQ54 | C (LVDS)* |
| P24 | PR56A | 2 | RDQ54 | T (LVDS)* |
| R26 | PR55B | 2 | RDQ54 | C |
| P27 | PR55A | 2 | RDQ54 | T |
| VCCIO | VCCIO2 | 2 | | |
| P25 | PR54B | 2 | RDQ54 | C (LVDS)* |
| P26 | PR54A | 2 | RDQS54 | T (LVDS)* |
| K30 | PR53B | 2 | RDQ54 | C |
| GNDIO | GNDIO2 | - | | |
| K29 | PR53A | 2 | RDQ54 | T |
| N22 | PR52B | 2 | RDQ54 | C (LVDS)* |
| P22 | PR52A | 2 | RDQ54 | T (LVDS)* |
| J30 | PR51B | 2 | RUM3_SPLLC_FB_A/RDQ54 | C |
| VCCIO | VCCIO2 | 2 | | |
| J29 | PR51A | 2 | RUM3_SPLLT_FB_A/RDQ54 | T |
| N24 | PR50B | 2 | RUM3_SPLLC_IN_A/RDQ54 | C (LVDS)* |
| N23 | PR50A | 2 | RUM3_SPLLT_IN_A/RDQ54 | T (LVDS)* |
| N25 | PR48B | 2 | RDQ45 | C |
| N26 | PR48A | 2 | RDQ45 | T |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| GNDIO | GNDIO2 | - | | |
| M27 | PR47B | 2 | RDQ45 | C (LVDS)* |
| M28 | PR47A | 2 | RDQ45 | T (LVDS)* |
| H30 | PR46B | 2 | RDQ45 | C |
| G30 | PR46A | 2 | RDQ45 | T |
| VCCIO | VCCIO2 | 2 | | |
| M25 | PR45B | 2 | RDQ45 | C (LVDS)* |
| M26 | PR45A | 2 | RDQS45 | T (LVDS)* |
| L30 | PR44B | 2 | RDQ45 | C |
| GNDIO | GNDIO2 | - | | |
| L29 | PR44A | 2 | RDQ45 | T |
| L28 | PR43B | 2 | RDQ45 | C (LVDS)* |
| L27 | PR43A | 2 | RDQ45 | T (LVDS)* |
| H29 | PR42B | 2 | RDQ45 | C |
| VCCIO | VCCIO2 | 2 | | |
| G29 | PR42A | 2 | RDQ45 | T |
| L22 | PR41B | 2 | RDQ45 | C (LVDS)* |
| M22 | PR41A | 2 | RDQ45 | T (LVDS)* |
| F30 | PR40B | 2 | | C |
| GNDIO | GNDIO2 | - | | |
| F29 | PR40A | 2 | | T |
| VCCIO | VCCIO2 | 2 | | |
| GNDIO | GNDIO2 | - | | |
| E30 | PR34B | 2 | RDQ32 | C (LVDS)* |
| E29 | PR34A | 2 | RDQ32 | T (LVDS)* |
| - | - | - | | |
| L25 | PR33B | 2 | RDQ32 | C |
| L26 | PR33A | 2 | RDQ32 | T |
| VCCIO | VCCIO2 | 2 | | |
| H28 | PR32B | 2 | RDQ32 | C (LVDS)* |
| J28 | PR32A | 2 | RDQS32 | T (LVDS)* |
| G28 | PR31B | 2 | RDQ32 | C |
| GNDIO | GNDIO2 | - | | |
| G27 | PR31A | 2 | RDQ32 | T |
| L24 | PR30B | 2 | RDQ32 | C (LVDS)* |
| L23 | PR30A | 2 | RDQ32 | T (LVDS)* |
| D30 | PR29B | 2 | RDQ32 | C |
| VCCIO | VCCIO2 | 2 | | |
| D29 | PR29A | 2 | RDQ32 | T |
| K24 | PR28B | 2 | RDQ32 | C (LVDS)* |
| K25 | PR28A | 2 | RDQ32 | T (LVDS)* |
| J27 | PR26B | 2 | RDQ23 | C |
| GNDIO | GNDIO2 | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| K26 | PR26A | 2 | RDQ23 | T |
| K23 | PR25B | 2 | RDQ23 | C (LVDS)* |
| K22 | PR25A | 2 | RDQ23 | T (LVDS)* |
| J22 | PR24B | 2 | RDQ23 | C |
| VCCIO | VCCIO2 | 2 | | |
| J23 | PR24A | 2 | RDQ23 | T |
| GNDIO | GNDIO2 | - | | |
| VCCIO | VCCIO2 | 2 | | |
| J26 | PR17B | 2 | RDQ15 | C (LVDS)* |
| H26 | PR17A | 2 | RDQ15 | T (LVDS)* |
| H27 | PR16B | 2 | RDQ15 | C |
| G26 | PR16A | 2 | RDQ15 | T |
| VCCIO | VCCIO2 | 2 | | |
| H23 | PR15B | 2 | RDQ15 | C (LVDS)* |
| H24 | PR15A | 2 | RDQS15 | T (LVDS)* |
| D28 | PR14B | 2 | RDQ15 | C |
| GNDIO | GNDIO2 | - | | |
| E28 | PR14A | 2 | RDQ15 | T |
| G24 | PR13B | 2 | RDQ15 | C (LVDS)* |
| H25 | PR13A | 2 | RDQ15 | T (LVDS)* |
| D27 | PR12B | 2 | RUM0_SPLLC_FB_A/RDQ15 | C |
| VCCIO | VCCIO2 | 2 | | |
| E27 | PR12A | 2 | RUM0_SPLLT_FB_A/RDQ15 | T |
| F26 | PR11B | 2 | RUM0_SPLLC_IN_A/RDQ15 | C (LVDS)* |
| G25 | PR11A | 2 | RUM0_SPLLT_IN_A/RDQ15 | T (LVDS)* |
| F24 | PR9B | 2 | VREF2_2 | C |
| - | - | - | | |
| GNDIO | GNDIO2 | - | | |
| F25 | PR9A | 2 | VREF1_2 | T |
| VCCIO | VCCIO2 | 2 | | |
| G23 | XRES | 1 | | |
| C30 | URC_SQ_VCCR0 | 12 | | |
| A29 | URC_SQ_HDINP0 | 12 | | T |
| B30 | URC_SQ_VCCIB0 | 12 | | |
| B29 | URC_SQ_HDINN0 | 12 | | C |
| C27 | URC_SQ_VCCTX0 | 12 | | |
| A26 | URC_SQ_HDOUTP0 | 12 | | T |
| A27 | URC_SQ_VCCOB0 | 12 | | |
| B26 | URC_SQ_HDOUTN0 | 12 | | C |
| C26 | URC_SQ_VCCTX1 | 12 | | |
| B25 | URC_SQ_HDOUTN1 | 12 | | C |
| C25 | URC_SQ_VCCOB1 | 12 | | |
| A25 | URC_SQ_HDOUTP1 | 12 | | T |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| C29 | URC_SQ_VCCR1 | 12 | | |
| B28 | URC_SQ_HDINN1 | 12 | | C |
| C28 | URC_SQ_VCCIB1 | 12 | | |
| A28 | URC_SQ_HDINP1 | 12 | | T |
| B24 | URC_SQ_VCCAUX33 | 12 | | |
| E24 | URC_SQ_REFCLKN | 12 | | C |
| D24 | URC_SQ_REFCLKP | 12 | | T |
| C24 | URC_SQ_VCCP | 12 | | |
| A20 | URC_SQ_HDINP2 | 12 | | T |
| C20 | URC_SQ_VCCIB2 | 12 | | |
| B20 | URC_SQ_HDINN2 | 12 | | C |
| C19 | URC_SQ_VCCR2 | 12 | | |
| A23 | URC_SQ_HDOUTP2 | 12 | | T |
| C23 | URC_SQ_VCCOB2 | 12 | | |
| B23 | URC_SQ_HDOUTN2 | 12 | | C |
| C22 | URC_SQ_VCCTX2 | 12 | | |
| B22 | URC_SQ_HDOUTN3 | 12 | | C |
| A21 | URC_SQ_VCCOB3 | 12 | | |
| A22 | URC_SQ_HDOUTP3 | 12 | | T |
| C21 | URC_SQ_VCCTX3 | 12 | | |
| B19 | URC_SQ_HDINN3 | 12 | | C |
| B18 | URC_SQ_VCCIB3 | 12 | | |
| A19 | URC_SQ_HDINP3 | 12 | | T |
| C18 | URC_SQ_VCCR3 | 12 | | |
| D23 | PT100B | 1 | | C |
| GNDIO | GNDIO1 | - | | |
| E21 | PT100A | 1 | | T |
| D26 | PT99B | 1 | | C |
| E26 | PT99A | 1 | | T |
| E23 | PT98B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | |
| G22 | PT98A | 1 | | T |
| - | - | - | | |
| D22 | PT97B | 1 | | C |
| F21 | PT97A | 1 | | T |
| G18 | PT96B | 1 | | C |
| H18 | PT96A | 1 | | T |
| D20 | PT95B | 1 | | C |
| GNDIO | GNDIO1 | - | | |
| D21 | PT95A | 1 | | T |
| E20 | PT94B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | |
| E19 | PT94A | 1 | | T |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| D19 | PT93B | 1 | | C |
| E18 | PT93A | 1 | | T |
| D18 | PT92B | 1 | | C |
| C17 | PT92A | 1 | | T |
| A17 | PT91B | 1 | | C |
| B17 | PT91A | 1 | | T |
| GNDIO | GNDIO1 | - | | |
| VCCIO | VCCIO1 | 1 | | |
| J18 | PT75B | 1 | | C |
| J19 | PT75A | 1 | | T |
| H17 | PT74B | 1 | | C |
| J17 | PT74A | 1 | | T |
| F18 | PT73B | 1 | | C |
| F17 | PT73A | 1 | | T |
| GNDIO | GNDIO1 | - | | |
| A16 | PT72B | 1 | | C |
| B16 | PT72A | 1 | | T |
| G17 | PT71B | 1 | | C |
| G16 | PT71A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| H16 | PT70B | 1 | | C |
| F16 | PT70A | 1 | | T |
| J16 | PT69B | 1 | | C |
| G15 | PT69A | 1 | | T |
| GNDIO | GNDIO1 | - | | |
| C16 | PT68B | 1 | | C |
| D16 | PT68A | 1 | | T |
| J15 | PT67B | 1 | | C |
| H15 | PT67A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | |
| A15 | PT66B | 1 | VREF2_1 | C |
| B15 | PT66A | 1 | VREF1_1 | T |
| F15 | PT65B | 1 | PCLKC1_0 | C |
| E16 | PT65A | 1 | PCLKT1_0 | T |
| C15 | PT64B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | |
| D15 | PT64A | 0 | PCLKT0_0 | T |
| C14 | PT63B | 0 | VREF2_0 | C |
| E15 | PT63A | 0 | VREF1_0 | T |
| G14 | PT62B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| J14 | PT62A | 0 | | T |
| F14 | PT61B | 0 | | C |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| H14 | PT61A | 0 | | T |
| A14 | PT60B | 0 | | C |
| B14 | PT60A | 0 | | T |
| D13 | PT59B | 0 | | C |
| GNDIO | GNDIO0 | - | | |
| F13 | PT59A | 0 | | T |
| G13 | PT58B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | |
| J11 | PT58A | 0 | | T |
| D4 | PT57B | 0 | | |
| D5 | PT56A | 0 | | |
| E5 | PT55B | 0 | | C |
| F6 | PT55A | 0 | | T |
| GNDIO | GNDIO0 | - | | |
| VCCIO | VCCIO0 | 0 | | |
| F7 | PT52B | 0 | | C |
| D8 | PT52A | 0 | | T |
| GNDIO | GNDIO0 | - | | |
| J13 | PT50B | 0 | | C |
| G11 | PT50A | 0 | | T |
| H13 | PT49B | 0 | | C |
| H12 | PT49A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | |
| E8 | PT48B | 0 | | C |
| D9 | PT48A | 0 | | T |
| D12 | PT46B | 0 | | C |
| GNDIO | GNDIO0 | - | | |
| E13 | PT46A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | |
| GNDIO | GNDIO0 | - | | |
| J12 | PT31B | 0 | | C |
| - | - | - | | |
| VCCIO | VCCIO0 | 0 | | |
| H10 | PT31A | 0 | | T |
| E12 | PT30B | 0 | | C |
| D11 | PT30A | 0 | | T |
| H11 | PT29B | 0 | | C |
| F11 | PT29A | 0 | | T |
| C13 | ULC_SQ_VCCR0 | 11 | | |
| A12 | ULC_SQ_HDINP0 | 11 | | T |
| B13 | ULC_SQ_VCCIB0 | 11 | | |
| B12 | ULC_SQ_HDINN0 | 11 | | C |
| C10 | ULC_SQ_VCCTX0 | 11 | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| A9 | ULC_SQ_HDOUTP0 | 11 | | T |
| A10 | ULC_SQ_VCCOB0 | 11 | | |
| B9 | ULC_SQ_HDOUTN0 | 11 | | C |
| C9 | ULC_SQ_VCCTX1 | 11 | | |
| B8 | ULC_SQ_HDOUTN1 | 11 | | C |
| C8 | ULC_SQ_VCCOB1 | 11 | | |
| A8 | ULC_SQ_HDOUTP1 | 11 | | T |
| C12 | ULC_SQ_VCCR1 | 11 | | |
| B11 | ULC_SQ_HDINN1 | 11 | | C |
| C11 | ULC_SQ_VCCIB1 | 11 | | |
| A11 | ULC_SQ_HDINP1 | 11 | | T |
| B7 | ULC_SQ_VCCAUX33 | 11 | | |
| E7 | ULC_SQ_REFCLKN | 11 | | C |
| D7 | ULC_SQ_REFCLKP | 11 | | T |
| C7 | ULC_SQ_VCCP | 11 | | |
| A3 | ULC_SQ_HDINP2 | 11 | | T |
| C3 | ULC_SQ_VCCIB2 | 11 | | |
| B3 | ULC_SQ_HDINN2 | 11 | | C |
| C2 | ULC_SQ_VCCR2 | 11 | | |
| A6 | ULC_SQ_HDOUTP2 | 11 | | T |
| C6 | ULC_SQ_VCCOB2 | 11 | | |
| B6 | ULC_SQ_HDOUTN2 | 11 | | C |
| C5 | ULC_SQ_VCCTX2 | 11 | | |
| B5 | ULC_SQ_HDOUTN3 | 11 | | C |
| A4 | ULC_SQ_VCCOB3 | 11 | | |
| A5 | ULC_SQ_HDOUTP3 | 11 | | T |
| C4 | ULC_SQ_VCCTX3 | 11 | | |
| B2 | ULC_SQ_HDINN3 | 11 | | C |
| B1 | ULC_SQ_VCCIB3 | 11 | | |
| A2 | ULC_SQ_HDINP3 | 11 | | T |
| C1 | ULC_SQ_VCCR3 | 11 | | |
| L12 | VCC | - | | |
| L13 | VCC | - | | |
| L18 | VCC | - | | |
| L19 | VCC | - | | |
| M11 | VCC | - | | |
| M12 | VCC | - | | |
| M13 | VCC | - | | |
| M14 | VCC | - | | |
| M15 | VCC | - | | |
| M16 | VCC | - | | |
| M17 | VCC | - | | |
| M18 | VCC | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| M19 | VCC | - | | |
| M20 | VCC | - | | |
| N11 | VCC | - | | |
| N12 | VCC | - | | |
| N19 | VCC | - | | |
| N20 | VCC | - | | |
| P12 | VCC | - | | |
| P19 | VCC | - | | |
| R12 | VCC | - | | |
| R19 | VCC | - | | |
| T12 | VCC | - | | |
| T19 | VCC | - | | |
| U12 | VCC | - | | |
| U19 | VCC | - | | |
| V11 | VCC | - | | |
| V12 | VCC | - | | |
| V19 | VCC | - | | |
| V20 | VCC | - | | |
| W11 | VCC | - | | |
| W12 | VCC | - | | |
| W13 | VCC | - | | |
| W14 | VCC | - | | |
| W15 | VCC | - | | |
| W16 | VCC | - | | |
| W17 | VCC | - | | |
| W18 | VCC | - | | |
| W19 | VCC | - | | |
| W20 | VCC | - | | |
| Y12 | VCC | - | | |
| Y13 | VCC | - | | |
| Y18 | VCC | - | | |
| Y19 | VCC | - | | |
| D14 | VCCIO0 | 0 | | |
| E6 | VCCIO0 | 0 | | |
| E9 | VCCIO0 | 0 | | |
| F12 | VCCIO0 | 0 | | |
| K12 | VCCIO0 | 0 | | |
| K13 | VCCIO0 | 0 | | |
| D17 | VCCIO1 | 1 | | |
| E22 | VCCIO1 | 1 | | |
| E25 | VCCIO1 | 1 | | |
| F19 | VCCIO1 | 1 | | |
| K18 | VCCIO1 | 1 | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| K19 | VCCIO1 | 1 | | |
| F28 | VCCIO2 | 2 | | |
| J25 | VCCIO2 | 2 | | |
| K28 | VCCIO2 | 2 | | |
| M21 | VCCIO2 | 2 | | |
| M24 | VCCIO2 | 2 | | |
| N21 | VCCIO2 | 2 | | |
| N28 | VCCIO2 | 2 | | |
| P21 | VCCIO2 | 2 | | |
| R25 | VCCIO2 | 2 | | |
| AA28 | VCCIO3 | 3 | | |
| AB25 | VCCIO3 | 3 | | |
| AE28 | VCCIO3 | 3 | | |
| T25 | VCCIO3 | 3 | | |
| U21 | VCCIO3 | 3 | | |
| V21 | VCCIO3 | 3 | | |
| V28 | VCCIO3 | 3 | | |
| W21 | VCCIO3 | 3 | | |
| W24 | VCCIO3 | 3 | | |
| AA18 | VCCIO4 | 4 | | |
| AA19 | VCCIO4 | 4 | | |
| AE19 | VCCIO4 | 4 | | |
| AF22 | VCCIO4 | 4 | | |
| AG17 | VCCIO4 | 4 | | |
| AG25 | VCCIO4 | 4 | | |
| AA12 | VCCIO5 | 5 | | |
| AA13 | VCCIO5 | 5 | | |
| AE12 | VCCIO5 | 5 | | |
| AF9 | VCCIO5 | 5 | | |
| AG14 | VCCIO5 | 5 | | |
| AG6 | VCCIO5 | 5 | | |
| AA3 | VCCIO6 | 6 | | |
| AB6 | VCCIO6 | 6 | | |
| AE3 | VCCIO6 | 6 | | |
| T6 | VCCIO6 | 6 | | |
| U10 | VCCIO6 | 6 | | |
| V10 | VCCIO6 | 6 | | |
| V3 | VCCIO6 | 6 | | |
| W10 | VCCIO6 | 6 | | |
| W7 | VCCIO6 | 6 | | |
| F3 | VCCIO7 | 7 | | |
| J6 | VCCIO7 | 7 | | |
| K3 | VCCIO7 | 7 | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| M10 | VCCIO7 | 7 | | |
| M7 | VCCIO7 | 7 | | |
| N10 | VCCIO7 | 7 | | |
| N3 | VCCIO7 | 7 | | |
| P10 | VCCIO7 | 7 | | |
| R6 | VCCIO7 | 7 | | |
| AA25 | VCCIO8 | 8 | | |
| AD28 | VCCIO8 | 8 | | |
| AA10 | VCCAUX | - | | |
| AA11 | VCCAUX | - | | |
| AA20 | VCCAUX | - | | |
| AA21 | VCCAUX | - | | |
| K10 | VCCAUX | - | | |
| K11 | VCCAUX | - | | |
| K20 | VCCAUX | - | | |
| K21 | VCCAUX | - | | |
| L10 | VCCAUX | - | | |
| L11 | VCCAUX | - | | |
| L20 | VCCAUX | - | | |
| L21 | VCCAUX | - | | |
| Y10 | VCCAUX | - | | |
| Y11 | VCCAUX | - | | |
| Y20 | VCCAUX | - | | |
| Y21 | VCCAUX | - | | |
| A1 | GND | - | | |
| A13 | GND | - | | |
| A18 | GND | - | | |
| A24 | GND | - | | |
| A30 | GND | - | | |
| A7 | GND | - | | |
| AA14 | GND | - | | |
| AA15 | GND | - | | |
| AA16 | GND | - | | |
| AA17 | GND | - | | |
| AA24 | GND | - | | |
| AA27 | GND | - | | |
| AA4 | GND | - | | |
| AB24 | GND | - | | |
| AB7 | GND | - | | |
| AD12 | GND | - | | |
| AD19 | GND | - | | |
| AD27 | GND | - | | |
| AE22 | GND | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AE27 | GND | - | | |
| AE4 | GND | - | | |
| AE9 | GND | - | | |
| AF14 | GND | - | | |
| AF17 | GND | - | | |
| AF25 | GND | - | | |
| AF6 | GND | - | | |
| AJ10 | GND | - | | |
| AJ21 | GND | - | | |
| AJ27 | GND | - | | |
| AJ4 | GND | - | | |
| AK1 | GND | - | | |
| AK13 | GND | - | | |
| AK18 | GND | - | | |
| AK24 | GND | - | | |
| AK30 | GND | - | | |
| AK7 | GND | - | | |
| B10 | GND | - | | |
| B21 | GND | - | | |
| B27 | GND | - | | |
| B4 | GND | - | | |
| D25 | GND | - | | |
| D6 | GND | - | | |
| E14 | GND | - | | |
| E17 | GND | - | | |
| F22 | GND | - | | |
| F27 | GND | - | | |
| F4 | GND | - | | |
| F9 | GND | - | | |
| G12 | GND | - | | |
| G19 | GND | - | | |
| J24 | GND | - | | |
| J7 | GND | - | | |
| K14 | GND | - | | |
| K15 | GND | - | | |
| K16 | GND | - | | |
| K17 | GND | - | | |
| K27 | GND | - | | |
| K4 | GND | - | | |
| L14 | GND | - | | |
| L15 | GND | - | | |
| L16 | GND | - | | |
| L17 | GND | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| M23 | GND | - | | |
| M8 | GND | - | | |
| N14 | GND | - | | |
| N15 | GND | - | | |
| N16 | GND | - | | |
| N17 | GND | - | | |
| N27 | GND | - | | |
| N4 | GND | - | | |
| P11 | GND | - | | |
| P13 | GND | - | | |
| P14 | GND | - | | |
| P15 | GND | - | | |
| P16 | GND | - | | |
| P17 | GND | - | | |
| P18 | GND | - | | |
| P20 | GND | - | | |
| R10 | GND | - | | |
| R11 | GND | - | | |
| R13 | GND | - | | |
| R14 | GND | - | | |
| R15 | GND | - | | |
| R16 | GND | - | | |
| R17 | GND | - | | |
| R18 | GND | - | | |
| R20 | GND | - | | |
| R21 | GND | - | | |
| R24 | GND | - | | |
| R7 | GND | - | | |
| T10 | GND | - | | |
| T11 | GND | - | | |
| T13 | GND | - | | |
| T14 | GND | - | | |
| T15 | GND | - | | |
| T16 | GND | - | | |
| T17 | GND | - | | |
| T18 | GND | - | | |
| T20 | GND | - | | |
| T21 | GND | - | | |
| T24 | GND | - | | |
| T7 | GND | - | | |
| U11 | GND | - | | |
| U13 | GND | - | | |
| U14 | GND | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| U15 | GND | - | | |
| U16 | GND | - | | |
| U17 | GND | - | | |
| U18 | GND | - | | |
| U20 | GND | - | | |
| V14 | GND | - | | |
| V15 | GND | - | | |
| V16 | GND | - | | |
| V17 | GND | - | | |
| V27 | GND | - | | |
| V4 | GND | - | | |
| W23 | GND | - | | |
| W8 | GND | - | | |
| Y14 | GND | - | | |
| Y15 | GND | - | | |
| Y16 | GND | - | | |
| Y17 | GND | - | | |
| AA26 | NC | - | | |
| AB10 | NC | - | | |
| AB11 | NC | - | | |
| AB12 | NC | - | | |
| AB13 | NC | - | | |
| AB14 | NC | - | | |
| AB15 | NC | - | | |
| AB16 | NC | - | | |
| AB17 | NC | - | | |
| AB19 | NC | - | | |
| AB20 | NC | - | | |
| AB21 | NC | - | | |
| AB9 | NC | - | | |
| AC10 | NC | - | | |
| AC11 | NC | - | | |
| AC21 | NC | - | | |
| AC22 | NC | - | | |
| AC8 | NC | - | | |
| AC9 | NC | - | | |
| AD21 | NC | - | | |
| AD22 | NC | - | | |
| AD4 | NC | - | | |
| AD5 | NC | - | | |
| AD6 | NC | - | | |
| AD7 | NC | - | | |
| AD8 | NC | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| AE23 | NC | - | | |
| AE5 | NC | - | | |
| AE6 | NC | - | | |
| AE7 | NC | - | | |
| AF20 | NC | - | | |
| AF23 | NC | - | | |
| AF5 | NC | - | | |
| AG23 | NC | - | | |
| AG26 | NC | - | | |
| D10 | NC | - | | |
| E10 | NC | - | | |
| E11 | NC | - | | |
| F10 | NC | - | | |
| F20 | NC | - | | |
| F23 | NC | - | | |
| F8 | NC | - | | |
| G10 | NC | - | | |
| G20 | NC | - | | |
| G21 | NC | - | | |
| G7 | NC | - | | |
| G8 | NC | - | | |
| G9 | NC | - | | |
| H19 | NC | - | | |
| H20 | NC | - | | |
| H21 | NC | - | | |
| H22 | NC | - | | |
| H6 | NC | - | | |
| H8 | NC | - | | |
| H9 | NC | - | | |
| J10 | NC | - | | |
| J20 | NC | - | | |
| J21 | NC | - | | |
| J9 | NC | - | | |
| K9 | NC | - | | |
| R9 | NC | - | | |
| U22 | NC | - | | |
| W9 | NC | - | | |
| N13 | VCCPLL | - | | |
| N18 | VCCPLL | - | | |
| V13 | VCCPLL | - | | |

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

| LFE2M100E/SE | | | | |
|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential |
| V18 | VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| F4 | PL9A | 7 | VREF2_7 | T | PL9A | 7 | VREF2_7 | T |
| F3 | PL9B | 7 | VREF1_7 | C | PL9B | 7 | VREF1_7 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| E1 | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* | PL11A | 7 | LUM0_SPLLT_IN_A/LDQ15 | T (LVDS)* |
| E2 | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C (LVDS)* | PL11B | 7 | LUM0_SPLLC_IN_A/LDQ15 | C (LVDS)* |
| K9 | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T | PL12A | 7 | LUM0_SPLLT_FB_A/LDQ15 | T |
| H7 | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C | PL12B | 7 | LUM0_SPLLC_FB_A/LDQ15 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| F1 | PL13A | 7 | LDQ15 | T (LVDS)* | PL13A | 7 | LDQ15 | T (LVDS)* |
| F2 | PL13B | 7 | LDQ15 | C (LVDS)* | PL13B | 7 | LDQ15 | C (LVDS)* |
| J8 | PL14A | 7 | LDQ15 | T | PL14A | 7 | LDQ15 | T |
| H6 | PL14B | 7 | LDQ15 | C | PL14B | 7 | LDQ15 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| G2 | PL15A | 7 | LDQS15 | T (LVDS)* | PL15A | 7 | LDQS15 | T (LVDS)* |
| G1 | PL15B | 7 | LDQ15 | C (LVDS)* | PL15B | 7 | LDQ15 | C (LVDS)* |
| J7 | PL16A | 7 | LDQ15 | T | PL16A | 7 | LDQ15 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| L8 | PL16B | 7 | LDQ15 | C | PL16B | 7 | LDQ15 | C |
| L9 | PL17A | 7 | LDQ15 | T (LVDS)* | PL17A | 7 | LDQ15 | T (LVDS)* |
| L10 | PL17B | 7 | LDQ15 | C (LVDS)* | PL17B | 7 | LDQ15 | C (LVDS)* |
| H5 | PL18A | 7 | LDQ15 | T | PL18A | 7 | LDQ15 | T |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| J6 | PL18B | 7 | LDQ15 | C | PL18B | 7 | LDQ15 | C |
| H2 | NC | - | | | PL19A | 7 | LDQ23 | T (LVDS)* |
| H1 | NC | - | | | PL19B | 7 | LDQ23 | C (LVDS)* |
| G5 | NC | - | | | PL20A | 7 | LDQ23 | T |
| G6 | NC | - | | | PL20B | 7 | LDQ23 | C |
| M9 | NC | - | | | PL21A | 7 | LDQ23 | T (LVDS)* |
| - | - | - | | | VCCIO7 | 7 | | |
| M10 | NC | - | | | PL21B | 7 | LDQ23 | C (LVDS)* |
| H3 | NC | - | | | PL22A | 7 | LDQ23 | T |
| H4 | NC | - | | | PL22B | 7 | LDQ23 | C |
| J2 | PL19A | 7 | | T (LVDS)* | PL23A | 7 | LDQS23 | T (LVDS)* |
| - | - | - | | | GNDIO7 | - | | |
| J1 | PL19B | 7 | | C (LVDS)* | PL23B | 7 | LDQ23 | C (LVDS)* |
| K2 | PL20A | 7 | | T | PL24A | 7 | LDQ23 | T |
| K1 | PL20B | 7 | | C | PL24B | 7 | LDQ23 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| J4 | PL21A | 7 | | T (LVDS)* | PL25A | 7 | LDQ23 | T (LVDS)* |
| J3 | PL21B | 7 | | C (LVDS)* | PL25B | 7 | LDQ23 | C (LVDS)* |
| J5 | PL22A | 7 | | T | PL26A | 7 | LDQ23 | T |
| K5 | PL22B | 7 | | C | PL26B | 7 | LDQ23 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| L2 | PL24A | 7 | LDQ28 | T (LVDS)* | PL28A | 7 | LDQ32 | T (LVDS)* |
| L1 | PL24B | 7 | LDQ28 | C (LVDS)* | PL28B | 7 | LDQ32 | C (LVDS)* |
| L7 | PL25A | 7 | LDQ28 | T | PL29A | 7 | LDQ32 | T |
| K6 | PL25B | 7 | LDQ28 | C | PL29B | 7 | LDQ32 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M2 | PL26A | 7 | LDQ28 | T (LVDS)* | PL30A | 7 | LDQ32 | T (LVDS)* |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| M1 | PL26B | 7 | LDQ28 | C (LVDS)* | PL30B | 7 | LDQ32 | C (LVDS)* |
| L6 | PL27A | 7 | LDQ28 | T | PL31A | 7 | LDQ32 | T |
| L5 | PL27B | 7 | LDQ28 | C | PL31B | 7 | LDQ32 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| L3 | PL28A | 7 | LDQS28 | T (LVDS)* | PL32A | 7 | LDQS32 | T (LVDS)* |
| L4 | PL28B | 7 | LDQ28 | C (LVDS)* | PL32B | 7 | LDQ32 | C (LVDS)* |
| M3 | PL29A | 7 | LDQ28 | T | PL33A | 7 | LDQ32 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| M4 | PL29B | 7 | LDQ28 | C | PL33B | 7 | LDQ32 | C |
| N1 | PL30A | 7 | LDQ28 | T (LVDS)* | PL34A | 7 | LDQ32 | T (LVDS)* |
| N2 | PL30B | 7 | LDQ28 | C (LVDS)* | PL34B | 7 | LDQ32 | C (LVDS)* |
| M5 | PL31A | 7 | LDQ28 | T | PL35A | 7 | LDQ32 | T |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| N6 | PL31B | 7 | LDQ28 | C | PL35B | 7 | LDQ32 | C |
| P3 | NC | - | | | PL37A | 7 | | T (LVDS)* |
| - | - | - | | | GNDIO7 | - | | |
| P4 | NC | - | | | PL37B | 7 | | C (LVDS)* |
| P9 | NC | - | | | PL38A | 7 | | T |
| M7 | NC | - | | | PL38B | 7 | | C |
| - | - | - | | | VCCIO7 | 7 | | |
| P1 | NC | - | | | PL39A | 7 | | T (LVDS)* |
| P2 | NC | - | | | PL39B | 7 | | C (LVDS)* |
| N7 | NC | - | | | PL40A | 7 | | T |
| P7 | NC | - | | | PL40B | 7 | | C |
| - | - | - | | | GNDIO7 | - | | |
| P5 | PL33A | 7 | LDQ37 | T (LVDS)* | PL41A | 7 | LDQ45 | T (LVDS)* |
| N5 | PL33B | 7 | LDQ37 | C (LVDS)* | PL41B | 7 | LDQ45 | C (LVDS)* |
| P8 | PL34A | 7 | LDQ37 | T | PL42A | 7 | LDQ45 | T |
| P6 | PL34B | 7 | LDQ37 | C | PL42B | 7 | LDQ45 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| R3 | PL35A | 7 | LDQ37 | T (LVDS)* | PL43A | 7 | LDQ45 | T (LVDS)* |
| R4 | PL35B | 7 | LDQ37 | C (LVDS)* | PL43B | 7 | LDQ45 | C (LVDS)* |
| R10 | PL36A | 7 | LDQ37 | T | PL44A | 7 | LDQ45 | T |
| P11 | PL36B | 7 | LDQ37 | C | PL44B | 7 | LDQ45 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| R7 | PL37A | 7 | LDQS37 | T (LVDS)* | PL45A | 7 | LDQS45 | T (LVDS)* |
| R8 | PL37B | 7 | LDQ37 | C (LVDS)* | PL45B | 7 | LDQ45 | C (LVDS)* |
| R5 | PL38A | 7 | LDQ37 | T | PL46A | 7 | LDQ45 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| T5 | PL38B | 7 | LDQ37 | C | PL46B | 7 | LDQ45 | C |
| R1 | PL39A | 7 | LDQ37 | T (LVDS)* | PL47A | 7 | LDQ45 | T (LVDS)* |
| R2 | PL39B | 7 | LDQ37 | C (LVDS)* | PL47B | 7 | LDQ45 | C (LVDS)* |
| R11 | PL40A | 7 | LDQ37 | T | PL48A | 7 | LDQ45 | T |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| T10 | PL40B | 7 | LDQ37 | C | PL48B | 7 | LDQ45 | C |
| T1 | PL42A | 7 | LUM3_SPLLT_IN_A/LDQ46 | T (LVDS)* | PL50A | 7 | LUM3_SPLLT_IN_A/LDQ54 | T (LVDS)* |
| T2 | PL42B | 7 | LUM3_SPLLC_IN_A/LDQ46 | C (LVDS)* | PL50B | 7 | LUM3_SPLLC_IN_A/LDQ54 | C (LVDS)* |
| U10 | PL43A | 7 | LUM3_SPLLT_FB_A/LDQ46 | T | PL51A | 7 | LUM3_SPLLT_FB_A/LDQ54 | T |
| U8 | PL43B | 7 | LUM3_SPLLC_FB_A/LDQ46 | C | PL51B | 7 | LUM3_SPLLC_FB_A/LDQ54 | C |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| T6 | PL44A | 7 | LDQ46 | T (LVDS)* | PL52A | 7 | LDQ54 | T (LVDS)* |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| R6 | PL44B | 7 | LDQ46 | C (LVDS)* | PL52B | 7 | LDQ54 | C (LVDS)* |
| U9 | PL45A | 7 | LDQ46 | T | PL53A | 7 | LDQ54 | T |
| T7 | PL45B | 7 | LDQ46 | C | PL53B | 7 | LDQ54 | C |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| U5 | PL46A | 7 | LDQS46 | T (LVDS)* | PL54A | 7 | LDQS54 | T (LVDS)* |
| U6 | PL46B | 7 | LDQ46 | C (LVDS)* | PL54B | 7 | LDQ54 | C (LVDS)* |
| U7 | PL47A | 7 | LDQ46 | T | PL55A | 7 | LDQ54 | T |
| VCCIO | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| V9 | PL47B | 7 | LDQ46 | C | PL55B | 7 | LDQ54 | C |
| V11 | PL48A | 7 | LDQ46 | T (LVDS)* | PL56A | 7 | LDQ54 | T (LVDS)* |
| V10 | PL48B | 7 | LDQ46 | C (LVDS)* | PL56B | 7 | LDQ54 | C (LVDS)* |
| U4 | PL49A | 7 | PCLKT7_0/LDQ46 | T | PL57A | 7 | PCLKT7_0/LDQ54 | T |
| GNDIO | GNDIO7 | - | | | GNDIO7 | - | | |
| U3 | PL49B | 7 | PCLKC7_0/LDQ46 | C | PL57B | 7 | PCLKC7_0/LDQ54 | C |
| U2 | PL51A | 6 | PCLKT6_0/LDQ55 | T (LVDS)* | PL59A | 6 | PCLKT6_0/LDQ63 | T (LVDS)* |
| U1 | PL51B | 6 | PCLKC6_0/LDQ55 | C (LVDS)* | PL59B | 6 | PCLKC6_0/LDQ63 | C (LVDS)* |
| V5 | PL52A | 6 | VREF2_6/LDQ55 | T | PL60A | 6 | VREF2_6/LDQ63 | T |
| V6 | PL52B | 6 | VREF1_6/LDQ55 | C | PL60B | 6 | VREF1_6/LDQ63 | C |
| V7 | PL53A | 6 | LDQ55 | T (LVDS)* | PL61A | 6 | LDQ63 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| V8 | PL53B | 6 | LDQ55 | C (LVDS)* | PL61B | 6 | LDQ63 | C (LVDS)* |
| V4 | PL54A | 6 | LDQ55 | T | PL62A | 6 | LDQ63 | T |
| V3 | PL54B | 6 | LDQ55 | C | PL62B | 6 | LDQ63 | C |
| V2 | PL55A | 6 | LDQS55 | T (LVDS)* | PL63A | 6 | LDQS63 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| V1 | PL55B | 6 | LDQ55 | C (LVDS)* | PL63B | 6 | LDQ63 | C (LVDS)* |
| W7 | PL56A | 6 | LDQ55 | T | PL64A | 6 | LDQ63 | T |
| W5 | PL56B | 6 | LDQ55 | C | PL64B | 6 | LDQ63 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W2 | PL57A | 6 | LLM3_SPLLT_IN_A/LDQ55 | T (LVDS)* | PL65A | 6 | LLM4_SPLLT_IN_A/LDQ63 | T (LVDS)* |
| W1 | PL57B | 6 | LLM3_SPLLC_IN_A/LDQ55 | C (LVDS)* | PL65B | 6 | LLM4_SPLLC_IN_A/LDQ63 | C (LVDS)* |
| Y6 | PL58A | 6 | LLM3_SPLLT_FB_A/LDQ55 | T | PL66A | 6 | LLM4_SPLLT_FB_A/LDQ63 | T |
| W6 | PL58B | 6 | LLM3_SPLLC_FB_A/LDQ55 | C | PL66B | 6 | LLM4_SPLLC_FB_A/LDQ63 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| Y1 | PL60A | 6 | LDQ64 | T (LVDS)* | PL68A | 6 | LDQ72 | T (LVDS)* |
| Y2 | PL60B | 6 | LDQ64 | C (LVDS)* | PL68B | 6 | LDQ72 | C (LVDS)* |
| Y7 | PL61A | 6 | LDQ64 | T | PL69A | 6 | LDQ72 | T |
| Y5 | PL61B | 6 | LDQ64 | C | PL69B | 6 | LDQ72 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W10 | PL62A | 6 | LDQ64 | T (LVDS)* | PL70A | 6 | LDQ72 | T (LVDS)* |
| Y8 | PL62B | 6 | LDQ64 | C (LVDS)* | PL70B | 6 | LDQ72 | C (LVDS)* |
| Y4 | PL63A | 6 | LDQ64 | T | PL71A | 6 | LDQ72 | T |
| Y3 | PL63B | 6 | LDQ64 | C | PL71B | 6 | LDQ72 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AA1 | PL64A | 6 | LDQS64 | T (LVDS)* | PL72A | 6 | LDQS72 | T (LVDS)* |
| AA2 | PL64B | 6 | LDQ64 | C (LVDS)* | PL72B | 6 | LDQ72 | C (LVDS)* |
| AA8 | PL65A | 6 | LDQ64 | T | PL73A | 6 | LDQ72 | T |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y9 | PL65B | 6 | LDQ64 | C | PL73B | 6 | LDQ72 | C |
| AA6 | PL66A | 6 | LDQ64 | T (LVDS)* | PL74A | 6 | LDQ72 | T (LVDS)* |
| AA7 | PL66B | 6 | LDQ64 | C (LVDS)* | PL74B | 6 | LDQ72 | C (LVDS)* |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AA4 | PL67A | 6 | LDQ64 | T | PL75A | 6 | LDQ72 | T |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AA3 | PL67B | 6 | LDQ64 | C | PL75B | 6 | LDQ72 | C |
| AA9 | PL69A | 6 | LDQ73 | T (LVDS)* | PL77A | 6 | LDQ81 | T (LVDS)* |
| AA10 | PL69B | 6 | LDQ73 | C (LVDS)* | PL77B | 6 | LDQ81 | C (LVDS)* |
| AA5 | PL70A | 6 | LDQ73 | T | PL78A | 6 | LDQ81 | T |
| AB6 | PL70B | 6 | LDQ73 | C | PL78B | 6 | LDQ81 | C |
| AB1 | PL71A | 6 | LDQ73 | T (LVDS)* | PL79A | 6 | LDQ81 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AB2 | PL71B | 6 | LDQ73 | C (LVDS)* | PL79B | 6 | LDQ81 | C (LVDS)* |
| AC8 | PL72A | 6 | LDQ73 | T | PL80A | 6 | LDQ81 | T |
| AB10 | PL72B | 6 | LDQ73 | C | PL80B | 6 | LDQ81 | C |
| AC1 | PL73A | 6 | LDQS73 | T (LVDS)* | PL81A | 6 | LDQS81 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AC2 | PL73B | 6 | LDQ73 | C (LVDS)* | PL81B | 6 | LDQ81 | C (LVDS)* |
| AB7 | PL74A | 6 | LDQ73 | T | PL82A | 6 | LDQ81 | T |
| AB5 | PL74B | 6 | LDQ73 | C | PL82B | 6 | LDQ81 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AC3 | PL75A | 6 | LDQ73 | T (LVDS)* | PL83A | 6 | LDQ81 | T (LVDS)* |
| AC4 | PL75B | 6 | LDQ73 | C (LVDS)* | PL83B | 6 | LDQ81 | C (LVDS)* |
| AC10 | PL76A | 6 | LDQ73 | T | PL84A | 6 | LDQ81 | T |
| AC9 | PL76B | 6 | LDQ73 | C | PL84B | 6 | LDQ81 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AC7 | NC | - | | | PL86A | 6 | LDQ90 | T (LVDS)* |
| AC5 | NC | - | | | PL86B | 6 | LDQ90 | C (LVDS)* |
| AC6 | NC | - | | | PL87A | 6 | LDQ90 | T |
| AD5 | NC | - | | | PL87B | 6 | LDQ90 | C |
| - | - | - | | | VCCIO6 | 6 | | |
| AD4 | NC | - | | | PL88A | 6 | LDQ90 | T (LVDS)* |
| AD3 | NC | - | | | PL88B | 6 | LDQ90 | C (LVDS)* |
| AD10 | NC | - | | | PL89A | 6 | LDQ90 | T |
| AD8 | NC | - | | | PL89B | 6 | LDQ90 | C |
| - | - | - | | | GNDIO6 | - | | |
| AD2 | NC | - | | | PL90A | 6 | LDQS90 | T (LVDS)* |
| AD1 | NC | - | | | PL90B | 6 | LDQ90 | C (LVDS)* |
| AD9 | NC | - | | | PL91A | 6 | LDQ90 | T |
| - | - | - | | | VCCIO6 | 6 | | |
| AC11 | NC | - | | | PL91B | 6 | LDQ90 | C |
| AD6 | NC | - | | | PL92A | 6 | LDQ90 | T (LVDS)* |
| AD7 | NC | - | | | PL92B | 6 | LDQ90 | C (LVDS)* |
| AE1 | NC | - | | | PL93A | 6 | LDQ90 | T |
| - | - | - | | | GNDIO6 | - | | |
| AE2 | NC | - | | | PL93B | 6 | LDQ90 | C |
| AF2 | PL78A | 6 | LDQ82 | T (LVDS)* | PL95A | 6 | LDQ99 | T (LVDS)* |
| AF1 | PL78B | 6 | LDQ82 | C (LVDS)* | PL95B | 6 | LDQ99 | C (LVDS)* |
| AE5 | PL79A | 6 | LDQ82 | T | PL96A | 6 | LDQ99 | T |
| AE6 | PL79B | 6 | LDQ82 | C | PL96B | 6 | LDQ99 | C |
| AF4 | PL80A | 6 | LDQ82 | T (LVDS)* | PL97A | 6 | LDQ99 | T (LVDS)* |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AF3 | PL80B | 6 | LDQ82 | C (LVDS)* | PL97B | 6 | LDQ99 | C (LVDS)* |
| AF5 | PL81A | 6 | LDQ82 | T | PL98A | 6 | LDQ99 | T |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|--------------------------|--------------|-------------------|------|------------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AF6 | PL81B | 6 | LDQ82 | C | PL98B | 6 | LDQ99 | C |
| AG1 | PL82A | 6 | LLM0_GPLLT_IN_A**/LDQS82 | T (LVDS)* | PL99A | 6 | LLM0_GPLLT_IN_A**/ LDQS99 | T (LVDS)* |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AG2 | PL82B | 6 | LLM0_GPLLC_IN_A**/LDQ82 | C (LVDS)* | PL99B | 6 | LLM0_GPLLC_IN_A**/LDQ99 | C (LVDS)* |
| AE9 | PL83A | 6 | LLM0_GPLLT_FB_A/LDQ82 | T | PL100A | 6 | LLM0_GPLLT_FB_A/LDQ99 | T |
| AF7 | PL83B | 6 | LLM0_GPLLC_FB_A/LDQ82 | C | PL100B | 6 | LLM0_GPLLC_FB_A/LDQ99 | C |
| VCCIO | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AH1 | PL84A | 6 | LLM0_GDLLT_IN_A**/LDQ82 | T (LVDS)* | PL101A | 6 | LLM0_GDLLT_IN_A**/LDQ99 | T (LVDS)* |
| AH2 | PL84B | 6 | LLM0_GDLLC_IN_A**/LDQ82 | C (LVDS)* | PL101B | 6 | LLM0_GDLLC_IN_A**/ LDQ99 | C (LVDS)* |
| AG5 | PL85A | 6 | LLM0_GDLLT_FB_A/LDQ82 | T | PL102A | 6 | LLM0_GDLLT_FB_A/LDQ99 | T |
| AG4 | PL85B | 6 | LLM0_GDLLC_FB_A/LDQ82 | C | PL102B | 6 | LLM0_GDLLC_FB_A/LDQ99 | C |
| GNDIO | GNDIO6 | - | | | GNDIO6 | - | | |
| AG6 | LLM0_PLLCAP | 6 | | | LLM0_PLLCAP | 6 | | |
| AJ1 | PL87A | 6 | | T | PL104A | 6 | | T |
| AJ2 | PL87B | 6 | | C | PL104B | 6 | | C |
| AK2 | TCK | - | | | TCK | - | | |
| AK1 | TDI | - | | | TDI | - | | |
| AL1 | TMS | - | | | TMS | - | | |
| AF10 | TDO | - | | | TDO | - | | |
| AK3 | VCCJ | - | | | VCCJ | - | | |
| AN2 | LLC_SQ_VCCR3 | 14 | | | LLC_SQ_VCCR3 | 14 | | |
| AM2 | LLC_SQ_HDINP3 | 14 | | T | LLC_SQ_HDINP3 | 14 | | T |
| AN1 | LLC_SQ_VCCIB3 | 14 | | | LLC_SQ_VCCIB3 | 14 | | |
| AM3 | LLC_SQ_HDINN3 | 14 | | C | LLC_SQ_HDINN3 | 14 | | C |
| AN3 | LLC_SQ_VCCTX3 | 14 | | | LLC_SQ_VCCTX3 | 14 | | |
| AP2 | LLC_SQ_HDOUTP3 | 14 | | T | LLC_SQ_HDOUTP3 | 14 | | T |
| AM1 | LLC_SQ_VCCOB3 | 14 | | | LLC_SQ_VCCOB3 | 14 | | |
| AP3 | LLC_SQ_HDOUTN3 | 14 | | C | LLC_SQ_HDOUTN3 | 14 | | C |
| AN4 | LLC_SQ_VCCTX2 | 14 | | | LLC_SQ_VCCTX2 | 14 | | |
| AP4 | LLC_SQ_HDOUTN2 | 14 | | C | LLC_SQ_HDOUTN2 | 14 | | C |
| AL3 | LLC_SQ_VCCOB2 | 14 | | | LLC_SQ_VCCOB2 | 14 | | |
| AP5 | LLC_SQ_HDOUTP2 | 14 | | T | LLC_SQ_HDOUTP2 | 14 | | T |
| AN5 | LLC_SQ_VCCR2 | 14 | | | LLC_SQ_VCCR2 | 14 | | |
| AM4 | LLC_SQ_HDINN2 | 14 | | C | LLC_SQ_HDINN2 | 14 | | C |
| AL4 | LLC_SQ_VCCIB2 | 14 | | | LLC_SQ_VCCIB2 | 14 | | |
| AM5 | LLC_SQ_HDINP2 | 14 | | T | LLC_SQ_HDINP2 | 14 | | T |
| AL6 | LLC_SQ_VCCP | 14 | | | LLC_SQ_VCCP | 14 | | |
| AL5 | LLC_SQ_REFCLKP | 14 | | T | LLC_SQ_REFCLKP | 14 | | T |
| AK5 | LLC_SQ_REFCLKN | 14 | | C | LLC_SQ_REFCLKN | 14 | | C |
| AK6 | LLC_SQ_VCCAUX33 | 14 | | | LLC_SQ_VCCAUX33 | 14 | | |
| AM6 | LLC_SQ_HDINP1 | 14 | | T | LLC_SQ_HDINP1 | 14 | | T |
| AL8 | LLC_SQ_VCCIB1 | 14 | | | LLC_SQ_VCCIB1 | 14 | | |
| AM7 | LLC_SQ_HDINN1 | 14 | | C | LLC_SQ_HDINN1 | 14 | | C |
| AN6 | LLC_SQ_VCCR1 | 14 | | | LLC_SQ_VCCR1 | 14 | | |
| AP6 | LLC_SQ_HDOUTP1 | 14 | | T | LLC_SQ_HDOUTP1 | 14 | | T |
| AK7 | LLC_SQ_VCCOB1 | 14 | | | LLC_SQ_VCCOB1 | 14 | | |
| AP7 | LLC_SQ_HDOUTN1 | 14 | | C | LLC_SQ_HDOUTN1 | 14 | | C |
| AN7 | LLC_SQ_VCCTX1 | 14 | | | LLC_SQ_VCCTX1 | 14 | | |
| AP8 | LLC_SQ_HDOUTN0 | 14 | | C | LLC_SQ_HDOUTN0 | 14 | | C |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AL9 | LLC_SQ_VCCOB0 | 14 | | | LLC_SQ_VCCOB0 | 14 | | |
| AP9 | LLC_SQ_HDOUTP0 | 14 | | T | LLC_SQ_HDOUTP0 | 14 | | T |
| AN8 | LLC_SQ_VCCTX0 | 14 | | | LLC_SQ_VCCTX0 | 14 | | |
| AM8 | LLC_SQ_HDINN0 | 14 | | C | LLC_SQ_HDINN0 | 14 | | C |
| AN9 | LLC_SQ_VCCIB0 | 14 | | | LLC_SQ_VCCIB0 | 14 | | |
| AM9 | LLC_SQ_HDINP0 | 14 | | T | LLC_SQ_HDINP0 | 14 | | T |
| AL7 | LLC_SQ_VCCRX0 | 14 | | | LLC_SQ_VCCRX0 | 14 | | |
| - | - | - | | | VCCIO5 | 5 | | |
| AJ12 | NC | - | | | PB32A | 5 | BDQ33 | T |
| AH12 | NC | - | | | PB32B | 5 | BDQ33 | C |
| - | - | - | | | GNDIO5 | - | | |
| - | - | - | | | VCCIO5 | 5 | | |
| AL13 | NC | - | | | PB36A | 5 | BDQ33 | T |
| AK13 | NC | - | | | PB36B | 5 | BDQ33 | C |
| - | - | - | | | GNDIO5 | - | | |
| AE14 | NC | - | | | PB38A | 5 | BDQ42 | T |
| AG13 | NC | - | | | PB38B | 5 | BDQ42 | C |
| AN14 | PB30A | 5 | BDQ33 | T | PB39A | 5 | BDQ42 | T |
| AP14 | PB30B | 5 | BDQ33 | C | PB39B | 5 | BDQ42 | C |
| AH14 | PB31A | 5 | BDQ33 | T | PB40A | 5 | BDQ42 | T |
| AJ15 | PB31B | 5 | BDQ33 | C | PB40B | 5 | BDQ42 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AL14 | PB33A | 5 | BDQS33 | T | PB42A | 5 | BDQS42 | T |
| AM14 | PB33B | 5 | BDQ33 | C | PB42B | 5 | BDQ42 | C |
| AF14 | PB35A | 5 | BDQ33 | T | PB44A | 5 | BDQ42 | T |
| AF13 | PB35B | 5 | BDQ33 | C | PB44B | 5 | BDQ42 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AE15 | PB36A | 5 | BDQ33 | T | PB45A | 5 | BDQ42 | T |
| AG14 | PB36B | 5 | BDQ33 | C | PB45B | 5 | BDQ42 | C |
| AH15 | PB37A | 5 | BDQ33 | T | PB46A | 5 | BDQ42 | T |
| AK15 | PB37B | 5 | BDQ33 | C | PB46B | 5 | BDQ42 | C |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AL15 | PB38A | 5 | BDQ42 | T | PB47A | 5 | BDQ51 | T |
| AM15 | PB38B | 5 | BDQ42 | C | PB47B | 5 | BDQ51 | C |
| AK16 | PB39A | 5 | BDQ42 | T | PB48A | 5 | BDQ51 | T |
| AJ16 | PB39B | 5 | BDQ42 | C | PB48B | 5 | BDQ51 | C |
| AN15 | PB40A | 5 | BDQ42 | T | PB49A | 5 | BDQ51 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AP15 | PB40B | 5 | BDQ42 | C | PB49B | 5 | BDQ51 | C |
| AG15 | PB42A | 5 | BDQS42 | T | PB51A | 5 | BDQS51 | T |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AE16 | PB42B | 5 | BDQ42 | C | PB51B | 5 | BDQ51 | C |
| AF15 | PB44A | 5 | BDQ42 | T | PB53A | 5 | BDQ51 | T |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AD16 | PB44B | 5 | BDQ42 | C | PB53B | 5 | BDQ51 | C |
| AK17 | PB45A | 5 | BDQ42 | T | PB54A | 5 | BDQ51 | T |
| AH16 | PB45B | 5 | BDQ42 | C | PB54B | 5 | BDQ51 | C |
| AN16 | PB46A | 5 | BDQ42 | T | PB55A | 5 | BDQ51 | T |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AP16 | PB46B | 5 | BDQ42 | C | PB55B | 5 | BDQ51 | C |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|----------------|--------------|-------------------|------|----------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AL17 | PB47A | 5 | BDQ51 | T | PB56A | 5 | BDQ60 | T |
| AM17 | PB47B | 5 | BDQ51 | C | PB56B | 5 | BDQ60 | C |
| AN17 | PB48A | 5 | BDQ51 | T | PB57A | 5 | BDQ60 | T |
| AP17 | PB48B | 5 | BDQ51 | C | PB57B | 5 | BDQ60 | C |
| AD17 | PB49A | 5 | BDQ51 | T | PB58A | 5 | BDQ60 | T |
| AE17 | PB49B | 5 | BDQ51 | C | PB58B | 5 | BDQ60 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AL18 | PB50A | 5 | BDQ51 | T | PB59A | 5 | BDQ60 | T |
| AM18 | PB50B | 5 | BDQ51 | C | PB59B | 5 | BDQ60 | C |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AP18 | PB51A | 5 | BDQS51 | T | PB60A | 5 | BDQS60 | T |
| AN18 | PB51B | 5 | BDQ51 | C | PB60B | 5 | BDQ60 | C |
| AG17 | PB52A | 5 | VREF2_5/BDQ51 | T | PB61A | 5 | VREF2_5/BDQ60 | T |
| AJ17 | PB52B | 5 | VREF1_5/BDQ51 | C | PB61B | 5 | VREF1_5/BDQ60 | C |
| AF17 | PB53A | 5 | PCLKT5_0/BDQ51 | T | PB62A | 5 | PCLKT5_0/BDQ60 | T |
| AH17 | PB53B | 5 | PCLKC5_0/BDQ51 | C | PB62B | 5 | PCLKC5_0/BDQ60 | C |
| VCCIO | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| GNDIO | GNDIO5 | - | | | GNDIO5 | - | | |
| AF18 | PB58A | 4 | PCLKT4_0/BDQ60 | T | PB67A | 4 | PCLKT4_0/BDQ69 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AD18 | PB58B | 4 | PCLKC4_0/BDQ60 | C | PB67B | 4 | PCLKC4_0/BDQ69 | C |
| AP19 | PB59A | 4 | VREF2_4/BDQ60 | T | PB68A | 4 | VREF2_4/BDQ69 | T |
| AN19 | PB59B | 4 | VREF1_4/BDQ60 | C | PB68B | 4 | VREF1_4/BDQ69 | C |
| AP20 | PB60A | 4 | BDQS60 | T | PB69A | 4 | BDQS69 | T |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AM20 | PB60B | 4 | BDQ60 | C | PB69B | 4 | BDQ69 | C |
| AN20 | PB61A | 4 | BDQ60 | T | PB70A | 4 | BDQ69 | T |
| AM21 | PB61B | 4 | BDQ60 | C | PB70B | 4 | BDQ69 | C |
| AG18 | PB62A | 4 | BDQ60 | T | PB71A | 4 | BDQ69 | T |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AE18 | PB62B | 4 | BDQ60 | C | PB71B | 4 | BDQ69 | C |
| AJ18 | PB63A | 4 | BDQ60 | T | PB72A | 4 | BDQ69 | T |
| AH18 | PB63B | 4 | BDQ60 | C | PB72B | 4 | BDQ69 | C |
| AK18 | PB64A | 4 | BDQ60 | T | PB73A | 4 | BDQ69 | T |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AK19 | PB64B | 4 | BDQ60 | C | PB73B | 4 | BDQ69 | C |
| AP21 | PB65A | 4 | BDQ69 | T | PB74A | 4 | BDQ78 | T |
| AN21 | PB65B | 4 | BDQ69 | C | PB74B | 4 | BDQ78 | C |
| AL20 | PB66A | 4 | BDQ69 | T | PB75A | 4 | BDQ78 | T |
| AK20 | PB66B | 4 | BDQ69 | C | PB75B | 4 | BDQ78 | C |
| AN22 | PB67A | 4 | BDQ69 | T | PB76A | 4 | BDQ78 | T |
| AL21 | PB67B | 4 | BDQ69 | C | PB76B | 4 | BDQ78 | C |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AH19 | PB69A | 4 | BDQS69 | T | PB78A | 4 | BDQS78 | T |
| AJ20 | PB69B | 4 | BDQ69 | C | PB78B | 4 | BDQ78 | C |
| AD20 | PB71A | 4 | BDQ69 | T | PB80A | 4 | BDQ78 | T |
| AF20 | PB71B | 4 | BDQ69 | C | PB80B | 4 | BDQ78 | C |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AJ19 | PB72A | 4 | BDQ69 | T | PB81A | 4 | BDQ78 | T |
| AH20 | PB72B | 4 | BDQ69 | C | PB81B | 4 | BDQ78 | C |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AE20 | PB73A | 4 | BDQ69 | T | PB82A | 4 | BDQ78 | T |
| AG20 | PB73B | 4 | BDQ69 | C | PB82B | 4 | BDQ78 | C |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AH22 | NC | - | | | PB89A | 4 | BDQ87 | T |
| - | - | - | | | VCCIO4 | 4 | | |
| AH21 | NC | - | | | PB89B | 4 | BDQ87 | C |
| AG22 | NC | - | | | PB90A | 4 | BDQ87 | T |
| AG21 | NC | - | | | PB90B | 4 | BDQ87 | C |
| - | - | - | | | GNDIO4 | - | | |
| AM22 | PB74A | 4 | BDQ78 | T | PB92A | 4 | BDQ96 | T |
| AL22 | PB74B | 4 | BDQ78 | C | PB92B | 4 | BDQ96 | C |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AP23 | PB77A | 4 | BDQ78 | T | PB95A | 4 | BDQ96 | T |
| AN23 | PB77B | 4 | BDQ78 | C | PB95B | 4 | BDQ96 | C |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AM24 | PB78A | 4 | BDQS78 | T | PB96A | 4 | BDQS96 | T |
| AL24 | PB78B | 4 | BDQ78 | C | PB96B | 4 | BDQ96 | C |
| AK22 | PB79A | 4 | BDQ78 | T | PB97A | 4 | BDQ96 | T |
| AJ22 | PB79B | 4 | BDQ78 | C | PB97B | 4 | BDQ96 | C |
| AL23 | PB80A | 4 | BDQ78 | T | PB98A | 4 | BDQ96 | T |
| AK23 | PB80B | 4 | BDQ78 | C | PB98B | 4 | BDQ96 | C |
| VCCIO | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AJ23 | PB81A | 4 | BDQ78 | T | PB99A | 4 | BDQ96 | T |
| AH23 | PB81B | 4 | BDQ78 | C | PB99B | 4 | BDQ96 | C |
| GNDIO | GNDIO4 | - | | | GNDIO4 | - | | |
| AL28 | LRC_SQ_VCCRX3 | 13 | | | LRC_SQ_VCCRX3 | 13 | | |
| AM26 | LRC_SQ_HDINP3 | 13 | | T | LRC_SQ_HDINP3 | 13 | | T |
| AN26 | LRC_SQ_VCCIB3 | 13 | | | LRC_SQ_VCCIB3 | 13 | | |
| AM27 | LRC_SQ_HDINN3 | 13 | | C | LRC_SQ_HDINN3 | 13 | | C |
| AN27 | LRC_SQ_VCCTX3 | 13 | | | LRC_SQ_VCCTX3 | 13 | | |
| AP26 | LRC_SQ_HDOUTP3 | 13 | | T | LRC_SQ_HDOUTP3 | 13 | | T |
| AL26 | LRC_SQ_VCCOB3 | 13 | | | LRC_SQ_VCCOB3 | 13 | | |
| AP27 | LRC_SQ_HDOUTN3 | 13 | | C | LRC_SQ_HDOUTN3 | 13 | | C |
| AN28 | LRC_SQ_VCCTX2 | 13 | | | LRC_SQ_VCCTX2 | 13 | | |
| AP28 | LRC_SQ_HDOUTN2 | 13 | | C | LRC_SQ_HDOUTN2 | 13 | | C |
| AK28 | LRC_SQ_VCCOB2 | 13 | | | LRC_SQ_VCCOB2 | 13 | | |
| AP29 | LRC_SQ_HDOUTP2 | 13 | | T | LRC_SQ_HDOUTP2 | 13 | | T |
| AN29 | LRC_SQ_VCCRX2 | 13 | | | LRC_SQ_VCCRX2 | 13 | | |
| AM28 | LRC_SQ_HDINN2 | 13 | | C | LRC_SQ_HDINN2 | 13 | | C |
| AL27 | LRC_SQ_VCCIB2 | 13 | | | LRC_SQ_VCCIB2 | 13 | | |
| AM29 | LRC_SQ_HDINP2 | 13 | | T | LRC_SQ_HDINP2 | 13 | | T |
| AL29 | LRC_SQ_VCCP | 13 | | | LRC_SQ_VCCP | 13 | | |
| AL30 | LRC_SQ_REFCLKP | 13 | | T | LRC_SQ_REFCLKP | 13 | | T |
| AK30 | LRC_SQ_REFCLKN | 13 | | C | LRC_SQ_REFCLKN | 13 | | C |
| AK29 | LRC_SQ_VCCAUX33 | 13 | | | LRC_SQ_VCCAUX33 | 13 | | |
| AM30 | LRC_SQ_HDINP1 | 13 | | T | LRC_SQ_HDINP1 | 13 | | T |
| AL31 | LRC_SQ_VCCIB1 | 13 | | | LRC_SQ_VCCIB1 | 13 | | |
| AM31 | LRC_SQ_HDINN1 | 13 | | C | LRC_SQ_HDINN1 | 13 | | C |
| AN30 | LRC_SQ_VCCRX1 | 13 | | | LRC_SQ_VCCRX1 | 13 | | |
| AP30 | LRC_SQ_HDOUTP1 | 13 | | T | LRC_SQ_HDOUTP1 | 13 | | T |
| AL32 | LRC_SQ_VCCOB1 | 13 | | | LRC_SQ_VCCOB1 | 13 | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|--------------------------|------|----------------------------|--------------|--------------------------|------|-----------------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AP31 | LRC_SQ_HDOUTN1 | 13 | | C | LRC_SQ_HDOUTN1 | 13 | | C |
| AN31 | LRC_SQ_VCCTX1 | 13 | | | LRC_SQ_VCCTX1 | 13 | | |
| AP32 | LRC_SQ_HDOUTN0 | 13 | | C | LRC_SQ_HDOUTN0 | 13 | | C |
| AM34 | LRC_SQ_VCCOB0 | 13 | | | LRC_SQ_VCCOB0 | 13 | | |
| AP33 | LRC_SQ_HDOUTP0 | 13 | | T | LRC_SQ_HDOUTP0 | 13 | | T |
| AN32 | LRC_SQ_VCCTX0 | 13 | | | LRC_SQ_VCCTX0 | 13 | | |
| AM32 | LRC_SQ_HDINN0 | 13 | | C | LRC_SQ_HDINN0 | 13 | | C |
| AN34 | LRC_SQ_VCCIB0 | 13 | | | LRC_SQ_VCCIB0 | 13 | | |
| AM33 | LRC_SQ_HDINP0 | 13 | | T | LRC_SQ_HDINP0 | 13 | | T |
| AN33 | LRC_SQ_VCCRX0 | 13 | | | LRC_SQ_VCCRX0 | 13 | | |
| AH28 | CFG2 | 8 | | | CFG2 | 8 | | |
| AD24 | CFG1 | 8 | | | CFG1 | 8 | | |
| AJ29 | CFG0 | 8 | | | CFG0 | 8 | | |
| AF25 | PROGRAMN | 8 | | | PROGRAMN | 8 | | |
| AJ28 | CCLK | 8 | | | CCLK | 8 | | |
| AE25 | INITN | 8 | | | INITN | 8 | | |
| AK31 | DONE | 8 | | | DONE | 8 | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| AE24 | WRITEN*** | 8 | | | WRITEN*** | 8 | | |
| AJ30 | CS1N*** | 8 | | | CS1N*** | 8 | | |
| AD25 | CSN*** | 8 | | | CSN*** | 8 | | |
| AG29 | D0/SPIFASTN*** | 8 | | | D0/SPIFASTN*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AG28 | D1*** | 8 | | | D1*** | 8 | | |
| AG30 | D2*** | 8 | | | D2*** | 8 | | |
| AH29 | D3*** | 8 | | | D3*** | 8 | | |
| GNDIO | GNDIO8 | - | | | GNDIO8 | - | | |
| AF26 | D4*** | 8 | | | D4*** | 8 | | |
| AH30 | D5*** | 8 | | | D5*** | 8 | | |
| AE26 | D6*** | 8 | | | D6*** | 8 | | |
| AJ31 | D7/SPID0*** | 8 | | | D7/SPID0*** | 8 | | |
| VCCIO | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AG27 | DI/CSSPI0N*** | 8 | | | DI/CSSPI0N*** | 8 | | |
| AK32 | DOUT/CSON/ CSSPI1N*** | 8 | | | DOUT/CSON/ CSSPI1N*** | 8 | | |
| AK33 | BUSY/SISPI*** | 8 | | | BUSY/SISPI*** | 8 | | |
| AF27 | RLM0_PLLCAP | 3 | | | RLM0_PLLCAP | 3 | | |
| AF28 | PR85B | 3 | RLM0_GDLLC_FB_A | C | PR102B | 3 | RLM0_GDLLC_FB_A/RDQ99 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| AD26 | PR85A | 3 | RLM0_GDLLT_FB_A | T | PR102A | 3 | RLM0_GDLLT_FB_A/RDQ99 | T |
| AJ32 | PR84B | 3 | RLM0_GDLLC_IN_A** | C (LVDS)* | PR101B | 3 | RLM0_GDLLC_IN_A**/ RDQ99 | C (LVDS)* |
| AJ33 | PR84A | 3 | RLM0_GDLLT_IN_A** | T (LVDS)* | PR101A | 3 | RLM0_GDLLT_IN_A**/ RDQ99 | T (LVDS)* |
| AJ34 | PR83B | 3 | RLM0_GPLLC_IN_A** | C | PR100B | 3 | RLM0_GPLLC_IN_A**/ RDQ99 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AK34 | PR83A | 3 | RLM0_GPLLT_IN_A** | T | PR100A | 3 | RLM0_GPLLT_IN_A**/ RDQ99 | T |
| AH33 | PR82B | 3 | RLM0_GPLLC_FB_A | C (LVDS)* | PR99B | 3 | RLM0_GPLLC_FB_A/RDQ99 | C (LVDS)* |
| AH34 | PR82A | 3 | RLM0_GPLLT_FB_A/RDQS82**** | T (LVDS)* | PR99A | 3 | RLM0_GPLLT_FB_A/ RDQS99 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AF29 | PR81B | 3 | RDQ82 | C | PR98B | 3 | RDQ99 | C |
| AF31 | PR81A | 3 | RDQ82 | T | PR98A | 3 | RDQ99 | T |
| AG33 | PR80B | 3 | RDQ82 | C (LVDS)* | PR97B | 3 | RDQ99 | C (LVDS)* |
| AG34 | PR80A | 3 | RDQ82 | T (LVDS)* | PR97A | 3 | RDQ99 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AF30 | PR79B | 3 | RDQ82 | C | PR96B | 3 | RDQ99 | C |
| AF32 | PR79A | 3 | RDQ82 | T | PR96A | 3 | RDQ99 | T |
| AE29 | PR78B | 3 | RDQ82 | C (LVDS)* | PR95B | 3 | RDQ99 | C (LVDS)* |
| AE30 | PR78A | 3 | RDQ82 | T (LVDS)* | PR95A | 3 | RDQ99 | T (LVDS)* |
| AF33 | NC | - | | | PR93B | 3 | RDQ90 | C |
| AF34 | NC | - | | | PR93A | 3 | RDQ90 | T |
| - | - | - | | | GNDIO3 | - | | |
| AC27 | NC | - | | | PR92B | 3 | RDQ90 | C (LVDS)* |
| AC28 | NC | - | | | PR92A | 3 | RDQ90 | T (LVDS)* |
| AD29 | NC | - | | | PR91B | 3 | RDQ90 | C |
| AD30 | NC | - | | | PR91A | 3 | RDQ90 | T |
| - | - | - | | | VCCIO3 | 3 | | |
| AE33 | NC | - | | | PR90B | 3 | RDQ90 | C (LVDS)* |
| AE34 | NC | - | | | PR90A | 3 | RDQS90 | T (LVDS)* |
| AD32 | NC | - | | | PR89B | 3 | RDQ90 | C |
| - | - | - | | | GNDIO3 | - | | |
| AD31 | NC | - | | | PR89A | 3 | RDQ90 | T |
| AB25 | NC | - | | | PR88B | 3 | RDQ90 | C (LVDS)* |
| AC25 | NC | - | | | PR88A | 3 | RDQ90 | T (LVDS)* |
| AB28 | NC | - | | | PR87B | 3 | RDQ90 | C |
| - | - | - | | | VCCIO3 | 3 | | |
| AA26 | NC | - | | | PR87A | 3 | RDQ90 | T |
| AD33 | NC | - | | | PR86B | 3 | RDQ90 | C (LVDS)* |
| AD34 | NC | - | | | PR86A | 3 | RDQ90 | T (LVDS)* |
| AC29 | PR76B | 3 | RDQ73 | C | PR84B | 3 | RDQ81 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| AA27 | PR76A | 3 | RDQ73 | T | PR84A | 3 | RDQ81 | T |
| AC32 | PR75B | 3 | RDQ73 | C (LVDS)* | PR83B | 3 | RDQ81 | C (LVDS)* |
| AC31 | PR75A | 3 | RDQ73 | T (LVDS)* | PR83A | 3 | RDQ81 | T (LVDS)* |
| AA25 | PR74B | 3 | RDQ73 | C | PR82B | 3 | RDQ81 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AC24 | PR74A | 3 | RDQ73 | T | PR82A | 3 | RDQ81 | T |
| AC33 | PR73B | 3 | RDQ73 | C (LVDS)* | PR81B | 3 | RDQ81 | C (LVDS)* |
| AC34 | PR73A | 3 | RDQS73 | T (LVDS)* | PR81A | 3 | RDQS81 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| AB24 | PR72B | 3 | RDQ73 | C | PR80B | 3 | RDQ81 | C |
| Y26 | PR72A | 3 | RDQ73 | T | PR80A | 3 | RDQ81 | T |
| AB33 | PR71B | 3 | RDQ73 | C (LVDS)* | PR79B | 3 | RDQ81 | C (LVDS)* |
| AB34 | PR71A | 3 | RDQ73 | T (LVDS)* | PR79A | 3 | RDQ81 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| Y27 | PR70B | 3 | RDQ73 | C | PR78B | 3 | RDQ81 | C |
| AB29 | PR70A | 3 | RDQ73 | T | PR78A | 3 | RDQ81 | T |
| AA34 | PR69B | 3 | RDQ73 | C (LVDS)* | PR77B | 3 | RDQ81 | C (LVDS)* |
| AA33 | PR69A | 3 | RDQ73 | T (LVDS)* | PR77A | 3 | RDQ81 | T (LVDS)* |
| AA31 | PR67B | 3 | RDQ64 | C | PR75B | 3 | RDQ72 | C |
| AA32 | PR67A | 3 | RDQ64 | T | PR75A | 3 | RDQ72 | T |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| AA28 | PR66B | 3 | RDQ64 | C (LVDS)* | PR74B | 3 | RDQ72 | C (LVDS)* |
| AA29 | PR66A | 3 | RDQ64 | T (LVDS)* | PR74A | 3 | RDQ72 | T (LVDS)* |
| AA30 | PR65B | 3 | RDQ64 | C | PR73B | 3 | RDQ72 | C |
| AB30 | PR65A | 3 | RDQ64 | T | PR73A | 3 | RDQ72 | T |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| Y28 | PR64B | 3 | RDQ64 | C (LVDS)* | PR72B | 3 | RDQ72 | C (LVDS)* |
| Y29 | PR64A | 3 | RDQS64 | T (LVDS)* | PR72A | 3 | RDQS72 | T (LVDS)* |
| AA24 | PR63B | 3 | RDQ64 | C | PR71B | 3 | RDQ72 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| Y25 | PR63A | 3 | RDQ64 | T | PR71A | 3 | RDQ72 | T |
| Y31 | PR62B | 3 | RDQ64 | C (LVDS)* | PR70B | 3 | RDQ72 | C (LVDS)* |
| Y30 | PR62A | 3 | RDQ64 | T (LVDS)* | PR70A | 3 | RDQ72 | T (LVDS)* |
| Y24 | PR61B | 3 | RDQ64 | C | PR69B | 3 | RDQ72 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| W25 | PR61A | 3 | RDQ64 | T | PR69A | 3 | RDQ72 | T |
| Y33 | PR60B | 3 | RDQ64 | C (LVDS)* | PR68B | 3 | RDQ72 | C (LVDS)* |
| Y34 | PR60A | 3 | RDQ64 | T (LVDS)* | PR68A | 3 | RDQ72 | T (LVDS)* |
| W28 | PR58B | 3 | RLM3_SPLLC_FB_A/RDQ55 | C | PR66B | 3 | RLM4_SPLLC_FB_A/RDQ63 | C |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| V26 | PR58A | 3 | RLM3_SPLLT_FB_A/RDQ55 | T | PR66A | 3 | RLM4_SPLLT_FB_A/RDQ63 | T |
| V28 | PR57B | 3 | RLM3_SPLLC_IN_A/RDQ55 | C (LVDS)* | PR65B | 3 | RLM4_SPLLC_IN_A/RDQ63 | C (LVDS)* |
| V27 | PR57A | 3 | RLM3_SPLLT_IN_A/RDQ55 | T (LVDS)* | PR65A | 3 | RLM4_SPLLT_IN_A/RDQ63 | T (LVDS)* |
| V25 | PR56B | 3 | RDQ55 | C | PR64B | 3 | RDQ63 | C |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| W24 | PR56A | 3 | RDQ55 | T | PR64A | 3 | RDQ63 | T |
| W33 | PR55B | 3 | RDQ55 | C (LVDS)* | PR63B | 3 | RDQ63 | C (LVDS)* |
| W34 | PR55A | 3 | RDQS55 | T (LVDS)* | PR63A | 3 | RDQS63 | T (LVDS)* |
| GNDIO | GNDIO3 | - | | | GNDIO3 | - | | |
| V24 | PR54B | 3 | RDQ55 | C | PR62B | 3 | RDQ63 | C |
| U26 | PR54A | 3 | RDQ55 | T | PR62A | 3 | RDQ63 | T |
| W29 | PR53B | 3 | RDQ55 | C (LVDS)* | PR61B | 3 | RDQ63 | C (LVDS)* |
| W30 | PR53A | 3 | RDQ55 | T (LVDS)* | PR61A | 3 | RDQ63 | T (LVDS)* |
| VCCIO | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| U27 | PR52B | 3 | VREF2_3/RDQ55 | C | PR60B | 3 | VREF2_3/RDQ63 | C |
| V29 | PR52A | 3 | VREF1_3/RDQ55 | T | PR60A | 3 | VREF1_3/RDQ63 | T |
| V31 | PR51B | 3 | PCLKC3_0/RDQ55 | C (LVDS)* | PR59B | 3 | PCLKC3_0/RDQ63 | C (LVDS)* |
| V32 | PR51A | 3 | PCLKT3_0/RDQ55 | T (LVDS)* | PR59A | 3 | PCLKT3_0/RDQ63 | T (LVDS)* |
| V33 | PR49B | 2 | PCLKC2_0/RDQ46 | C | PR57B | 2 | PCLKC2_0/RDQ54 | C |
| V34 | PR49A | 2 | PCLKT2_0/RDQ46 | T | PR57A | 2 | PCLKT2_0/RDQ54 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| U24 | PR48B | 2 | RDQ46 | C (LVDS)* | PR56B | 2 | RDQ54 | C (LVDS)* |
| U25 | PR48A | 2 | RDQ46 | T (LVDS)* | PR56A | 2 | RDQ54 | T (LVDS)* |
| V30 | PR47B | 2 | RDQ46 | C | PR55B | 2 | RDQ54 | C |
| Y32 | PR47A | 2 | RDQ46 | T | PR55A | 2 | RDQ54 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| U28 | PR46B | 2 | RDQ46 | C (LVDS)* | PR54B | 2 | RDQ54 | C (LVDS)* |
| U29 | PR46A | 2 | RDQS46 | T (LVDS)* | PR54A | 2 | RDQS54 | T (LVDS)* |
| U33 | PR45B | 2 | RDQ46 | C | PR53B | 2 | RDQ54 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| U34 | PR45A | 2 | RDQ46 | T | PR53A | 2 | RDQ54 | T |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| T30 | PR44B | 2 | RDQ46 | C (LVDS)* | PR52B | 2 | RDQ54 | C (LVDS)* |
| U30 | PR44A | 2 | RDQ46 | T (LVDS)* | PR52A | 2 | RDQ54 | T (LVDS)* |
| T29 | PR43B | 2 | RUM3_SPLLC_FB_A/RDQ46 | C | PR51B | 2 | RUM3_SPLLC_FB_A/RDQ54 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| T28 | PR43A | 2 | RUM3_SPLLT_FB_A/RDQ46 | T | PR51A | 2 | RUM3_SPLLT_FB_A/RDQ54 | T |
| U31 | PR42B | 2 | RUM3_SPLLC_IN_A/RDQ46 | C (LVDS)* | PR50B | 2 | RUM3_SPLLC_IN_A/RDQ54 | C (LVDS)* |
| U32 | PR42A | 2 | RUM3_SPLLT_IN_A/RDQ46 | T (LVDS)* | PR50A | 2 | RUM3_SPLLT_IN_A/RDQ54 | T (LVDS)* |
| T33 | PR40B | 2 | RDQ37 | C | PR48B | 2 | RDQ45 | C |
| T34 | PR40A | 2 | RDQ37 | T | PR48A | 2 | RDQ45 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| R27 | PR39B | 2 | RDQ37 | C (LVDS)* | PR47B | 2 | RDQ45 | C (LVDS)* |
| R28 | PR39A | 2 | RDQ37 | T (LVDS)* | PR47A | 2 | RDQ45 | T (LVDS)* |
| R29 | PR38B | 2 | RDQ37 | C | PR46B | 2 | RDQ45 | C |
| R30 | PR38A | 2 | RDQ37 | T | PR46A | 2 | RDQ45 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| R33 | PR37B | 2 | RDQ37 | C (LVDS)* | PR45B | 2 | RDQ45 | C (LVDS)* |
| R34 | PR37A | 2 | RDQS37 | T (LVDS)* | PR45A | 2 | RDQS45 | T (LVDS)* |
| R32 | PR36B | 2 | RDQ37 | C | PR44B | 2 | RDQ45 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| R31 | PR36A | 2 | RDQ37 | T | PR44A | 2 | RDQ45 | T |
| P34 | PR35B | 2 | RDQ37 | C (LVDS)* | PR43B | 2 | RDQ45 | C (LVDS)* |
| P33 | PR35A | 2 | RDQ37 | T (LVDS)* | PR43A | 2 | RDQ45 | T (LVDS)* |
| R26 | PR34B | 2 | RDQ37 | C | PR42B | 2 | RDQ45 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| T25 | PR34A | 2 | RDQ37 | T | PR42A | 2 | RDQ45 | T |
| P28 | PR33B | 2 | RDQ37 | C (LVDS)* | PR41B | 2 | RDQ45 | C (LVDS)* |
| P27 | PR33A | 2 | RDQ37 | T (LVDS)* | PR41A | 2 | RDQ45 | T (LVDS)* |
| P30 | NC | - | | | PR40B | 2 | | C |
| - | - | - | | | GNDIO2 | - | | |
| P29 | NC | - | | | PR40A | 2 | | T |
| P31 | NC | - | | | PR39B | 2 | | C (LVDS)* |
| P32 | NC | - | | | PR39A | 2 | | T (LVDS)* |
| R25 | NC | - | | | PR38B | 2 | | C |
| - | - | - | | | VCCIO2 | 2 | | |
| T24 | NC | - | | | PR38A | 2 | | T |
| N34 | NC | - | | | PR37B | 2 | | C (LVDS)* |
| N33 | NC | - | | | PR37A | 2 | | T (LVDS)* |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| M34 | PR31B | 2 | RDQ28 | C | PR35B | 2 | RDQ32 | C |
| M33 | PR31A | 2 | RDQ28 | T | PR35A | 2 | RDQ32 | T |
| - | - | - | | | GNDIO2 | - | | |
| R24 | PR30B | 2 | RDQ28 | C (LVDS)* | PR34B | 2 | RDQ32 | C (LVDS)* |
| P24 | PR30A | 2 | RDQ28 | T (LVDS)* | PR34A | 2 | RDQ32 | T (LVDS)* |
| N30 | PR29B | 2 | RDQ28 | C | PR33B | 2 | RDQ32 | C |
| M29 | PR29A | 2 | RDQ28 | T | PR33A | 2 | RDQ32 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| N28 | PR28B | 2 | RDQ28 | C (LVDS)* | PR32B | 2 | RDQ32 | C (LVDS)* |
| N29 | PR28A | 2 | RDQS28 | T (LVDS)* | PR32A | 2 | RDQS32 | T (LVDS)* |
| N24 | PR27B | 2 | RDQ28 | C | PR31B | 2 | RDQ32 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| N25 | PR27A | 2 | RDQ28 | T | PR31A | 2 | RDQ32 | T |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|-----------------------|--------------|-------------------|------|-----------------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| M28 | PR26B | 2 | RDQ28 | C (LVDS)* | PR30B | 2 | RDQ32 | C (LVDS)* |
| M27 | PR26A | 2 | RDQ28 | T (LVDS)* | PR30A | 2 | RDQ32 | T (LVDS)* |
| L27 | PR25B | 2 | RDQ28 | C | PR29B | 2 | RDQ32 | C |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| M26 | PR25A | 2 | RDQ28 | T | PR29A | 2 | RDQ32 | T |
| M32 | PR24B | 2 | RDQ28 | C (LVDS)* | PR28B | 2 | RDQ32 | C (LVDS)* |
| M31 | PR24A | 2 | RDQ28 | T (LVDS)* | PR28A | 2 | RDQ32 | T (LVDS)* |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| - | - | - | | | VCCIO2 | 2 | | |
| L34 | PR22B | 2 | | C | PR22B | 2 | RDQ23 | C |
| L33 | PR22A | 2 | | T | PR22A | 2 | RDQ23 | T |
| L32 | PR21B | 2 | | C (LVDS)* | PR21B | 2 | RDQ23 | C (LVDS)* |
| L31 | PR21A | 2 | | T (LVDS)* | PR21A | 2 | RDQ23 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| L28 | PR20B | 2 | | C | PR20B | 2 | RDQ23 | C |
| L29 | PR20A | 2 | | T | PR20A | 2 | RDQ23 | T |
| M30 | PR19B | 2 | | C (LVDS)* | PR19B | 2 | RDQ23 | C (LVDS)* |
| L30 | PR19A | 2 | | T (LVDS)* | PR19A | 2 | RDQ23 | T (LVDS)* |
| K34 | PR18B | 2 | RDQ15 | C | PR18B | 2 | RDQ15 | C |
| K33 | PR18A | 2 | RDQ15 | T | PR18A | 2 | RDQ15 | T |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| K30 | PR17B | 2 | RDQ15 | C (LVDS)* | PR17B | 2 | RDQ15 | C (LVDS)* |
| K29 | PR17A | 2 | RDQ15 | T (LVDS)* | PR17A | 2 | RDQ15 | T (LVDS)* |
| J34 | PR16B | 2 | RDQ15 | C | PR16B | 2 | RDQ15 | C |
| J33 | PR16A | 2 | RDQ15 | T | PR16A | 2 | RDQ15 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J32 | PR15B | 2 | RDQ15 | C (LVDS)* | PR15B | 2 | RDQ15 | C (LVDS)* |
| J31 | PR15A | 2 | RDQS15 | T (LVDS)* | PR15A | 2 | RDQS15 | T (LVDS)* |
| H33 | PR14B | 2 | RDQ15 | C | PR14B | 2 | RDQ15 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| H34 | PR14A | 2 | RDQ15 | T | PR14A | 2 | RDQ15 | T |
| J30 | PR13B | 2 | RDQ15 | C (LVDS)* | PR13B | 2 | RDQ15 | C (LVDS)* |
| J29 | PR13A | 2 | RDQ15 | T (LVDS)* | PR13A | 2 | RDQ15 | T (LVDS)* |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| J27 | PR11B | 2 | RUM0_SPLLC_IN_A/RDQ15 | C (LVDS)* | PR11B | 2 | RUM0_SPLLC_IN_A/RDQ15 | C (LVDS)* |
| J28 | PR11A | 2 | RUM0_SPLLT_IN_A/RDQ15 | T (LVDS)* | PR11A | 2 | RUM0_SPLLT_IN_A/RDQ15 | T (LVDS)* |
| H31 | PR9B | 2 | VREF2_2 | C | PR9B | 2 | VREF2_2 | C |
| GNDIO | GNDIO2 | - | | | GNDIO2 | - | | |
| H32 | PR9A | 2 | VREF1_2 | T | PR9A | 2 | VREF1_2 | T |
| VCCIO | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| H30 | XRES | 1 | | | XRES | 1 | | |
| B33 | URC_SQ_VCCRX0 | 12 | | | URC_SQ_VCCRX0 | 12 | | |
| C33 | URC_SQ_HDINP0 | 12 | | T | URC_SQ_HDINP0 | 12 | | T |
| B34 | URC_SQ_VCCIB0 | 12 | | | URC_SQ_VCCIB0 | 12 | | |
| C32 | URC_SQ_HDINN0 | 12 | | C | URC_SQ_HDINN0 | 12 | | C |
| B32 | URC_SQ_VCCTX0 | 12 | | | URC_SQ_VCCTX0 | 12 | | |
| A33 | URC_SQ_HDOUTP0 | 12 | | T | URC_SQ_HDOUTP0 | 12 | | T |
| C34 | URC_SQ_VCCOB0 | 12 | | | URC_SQ_VCCOB0 | 12 | | |
| A32 | URC_SQ_HDOUTN0 | 12 | | C | URC_SQ_HDOUTN0 | 12 | | C |
| B31 | URC_SQ_VCCTX1 | 12 | | | URC_SQ_VCCTX1 | 12 | | |
| A31 | URC_SQ_HDOUTN1 | 12 | | C | URC_SQ_HDOUTN1 | 12 | | C |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D32 | URC_SQ_VCCOB1 | 12 | | | URC_SQ_VCCOB1 | 12 | | |
| A30 | URC_SQ_HDOUTP1 | 12 | | T | URC_SQ_HDOUTP1 | 12 | | T |
| B30 | URC_SQ_VCCRX1 | 12 | | | URC_SQ_VCCRX1 | 12 | | |
| C31 | URC_SQ_HDINN1 | 12 | | C | URC_SQ_HDINN1 | 12 | | C |
| D31 | URC_SQ_VCCIB1 | 12 | | | URC_SQ_VCCIB1 | 12 | | |
| C30 | URC_SQ_HDINP1 | 12 | | T | URC_SQ_HDINP1 | 12 | | T |
| E29 | URC_SQ_VCCAUX33 | 12 | | | URC_SQ_VCCAUX33 | 12 | | |
| E30 | URC_SQ_REFCLKN | 12 | | C | URC_SQ_REFCLKN | 12 | | C |
| D30 | URC_SQ_REFCLKP | 12 | | T | URC_SQ_REFCLKP | 12 | | T |
| D29 | URC_SQ_VCCP | 12 | | | URC_SQ_VCCP | 12 | | |
| C29 | URC_SQ_HDINP2 | 12 | | T | URC_SQ_HDINP2 | 12 | | T |
| D27 | URC_SQ_VCCIB2 | 12 | | | URC_SQ_VCCIB2 | 12 | | |
| C28 | URC_SQ_HDINN2 | 12 | | C | URC_SQ_HDINN2 | 12 | | C |
| B29 | URC_SQ_VCCRX2 | 12 | | | URC_SQ_VCCRX2 | 12 | | |
| A29 | URC_SQ_HDOUTP2 | 12 | | T | URC_SQ_HDOUTP2 | 12 | | T |
| E28 | URC_SQ_VCCOB2 | 12 | | | URC_SQ_VCCOB2 | 12 | | |
| A28 | URC_SQ_HDOUTN2 | 12 | | C | URC_SQ_HDOUTN2 | 12 | | C |
| B28 | URC_SQ_VCCTX2 | 12 | | | URC_SQ_VCCTX2 | 12 | | |
| A27 | URC_SQ_HDOUTN3 | 12 | | C | URC_SQ_HDOUTN3 | 12 | | C |
| D26 | URC_SQ_VCCOB3 | 12 | | | URC_SQ_VCCOB3 | 12 | | |
| A26 | URC_SQ_HDOUTP3 | 12 | | T | URC_SQ_HDOUTP3 | 12 | | T |
| B27 | URC_SQ_VCCTX3 | 12 | | | URC_SQ_VCCTX3 | 12 | | |
| C27 | URC_SQ_HDINN3 | 12 | | C | URC_SQ_HDINN3 | 12 | | C |
| B26 | URC_SQ_VCCIB3 | 12 | | | URC_SQ_VCCIB3 | 12 | | |
| C26 | URC_SQ_HDINP3 | 12 | | T | URC_SQ_HDINP3 | 12 | | T |
| D28 | URC_SQ_VCCRX3 | 12 | | | URC_SQ_VCCRX3 | 12 | | |
| E23 | PT82B | 1 | | C | PT100B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| F23 | PT82A | 1 | | T | PT100A | 1 | | T |
| F24 | NC | - | | | PT99B | 1 | | C |
| G23 | NC | - | | | PT99A | 1 | | T |
| D23 | PT80B | 1 | | C | PT98B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| D22 | PT80A | 1 | | T | PT98A | 1 | | T |
| - | - | - | | | GNDIO1 | - | | |
| - | - | - | | | VCCIO1 | 1 | | |
| C21 | PT79B | 1 | | C | PT88B | 1 | | C |
| D21 | PT79A | 1 | | T | PT88A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| B21 | PT77B | 1 | | C | PT86B | 1 | | C |
| A21 | PT77A | 1 | | T | PT86A | 1 | | T |
| F22 | PT76B | 1 | | C | PT85B | 1 | | C |
| E22 | PT76A | 1 | | T | PT85A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| GNDIO | GNDIO1 | - | | | - | - | | |
| J22 | NC | - | | | PT84B | 1 | | C |
| G22 | NC | - | | | PT84A | 1 | | T |
| - | - | - | | | GNDIO1 | - | | |
| H22 | PT72B | 1 | | C | PT81B | 1 | | C |
| K22 | PT72A | 1 | | T | PT81A | 1 | | T |
| G21 | PT71B | 1 | | C | PT80B | 1 | | C |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| J21 | PT71A | 1 | | T | PT80A | 1 | | T |
| H21 | NC | - | | | PT79B | 1 | | C |
| K21 | NC | - | | | PT79A | 1 | | T |
| D20 | PT69B | 1 | | C | PT78B | 1 | | C |
| F20 | PT69A | 1 | | T | PT78A | 1 | | T |
| C20 | PT68B | 1 | | C | PT77B | 1 | | C |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| E20 | PT68A | 1 | | T | PT77A | 1 | | T |
| G20 | PT67B | 1 | | C | PT76B | 1 | | C |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| J20 | PT67A | 1 | | T | PT76A | 1 | | T |
| A20 | PT66B | 1 | | C | PT75B | 1 | | C |
| B20 | PT66A | 1 | | T | PT75A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| A19 | PT63B | 1 | | C | PT72B | 1 | | C |
| B19 | PT63A | 1 | | T | PT72A | 1 | | T |
| K20 | PT62B | 1 | | C | PT71B | 1 | | C |
| H20 | PT62A | 1 | | T | PT71A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| L19 | NC | - | | | PT70B | 1 | | C |
| L20 | NC | - | | | PT70A | 1 | | T |
| E19 | PT60B | 1 | | C | PT69B | 1 | | C |
| C18 | PT60A | 1 | | T | PT69A | 1 | | T |
| GNDIO | GNDIO1 | - | | | GNDIO1 | - | | |
| F19 | PT59B | 1 | | C | PT68B | 1 | | C |
| D18 | PT59A | 1 | | T | PT68A | 1 | | T |
| L18 | NC | - | | | PT67B | 1 | | C |
| K19 | NC | - | | | PT67A | 1 | | T |
| VCCIO | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| A18 | PT57B | 1 | VREF2_1 | C | PT66B | 1 | VREF2_1 | C |
| B18 | PT57A | 1 | VREF1_1 | T | PT66A | 1 | VREF1_1 | T |
| G18 | PT56B | 1 | PCLKC1_0 | C | PT65B | 1 | PCLKC1_0 | C |
| E18 | PT56A | 1 | PCLKT1_0 | T | PT65A | 1 | PCLKT1_0 | T |
| F18 | PT55B | 0 | PCLKC0_0 | C | PT64B | 0 | PCLKC0_0 | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| G19 | PT55A | 0 | PCLKT0_0 | T | PT64A | 0 | PCLKT0_0 | T |
| H18 | PT54B | 0 | VREF2_0 | C | PT63B | 0 | VREF2_0 | C |
| K18 | PT54A | 0 | VREF1_0 | T | PT63A | 0 | VREF1_0 | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| J18 | PT53B | 0 | | C | PT60B | 0 | | C |
| L17 | PT53A | 0 | | T | PT60A | 0 | | T |
| G17 | PT52B | 0 | | C | PT59B | 0 | | C |
| - | - | - | | | GNDIO0 | - | | |
| J17 | PT52A | 0 | | T | PT59A | 0 | | T |
| H17 | PT51B | 0 | | C | PT58B | 0 | | C |
| - | - | - | | | VCCIO0 | 0 | | |
| K17 | PT51A | 0 | | T | PT58A | 0 | | T |
| B17 | PT50B | 0 | | C | PT57B | 0 | | C |
| GNDIO | GNDIO0 | - | | | - | - | | |
| A17 | PT50A | 0 | | T | PT57A | 0 | | T |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D17 | PT49B | 0 | | C | PT56B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | - | - | | |
| F17 | PT49A | 0 | | T | PT56A | 0 | | T |
| B16 | PT48B | 0 | | C | PT55B | 0 | | C |
| A16 | PT48A | 0 | | T | PT55A | 0 | | T |
| - | - | - | | | GNDIO0 | - | | |
| - | - | - | | | VCCIO0 | 0 | | |
| E17 | PT47B | 0 | | C | PT52B | 0 | | C |
| C17 | PT47A | 0 | | T | PT52A | 0 | | T |
| K16 | PT46B | 0 | | C | PT51B | 0 | | C |
| J15 | PT46A | 0 | | T | PT51A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| G16 | PT45B | 0 | | C | PT50B | 0 | | C |
| H15 | PT45A | 0 | | T | PT50A | 0 | | T |
| A15 | PT44B | 0 | | C | PT49B | 0 | | C |
| B15 | PT44A | 0 | | T | PT49A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| L16 | PT43B | 0 | | C | PT48B | 0 | | C |
| K15 | PT43A | 0 | | T | PT48A | 0 | | T |
| F16 | PT42B | 0 | | C | PT47B | 0 | | C |
| E16 | PT42A | 0 | | T | PT47A | 0 | | T |
| E15 | PT41B | 0 | | C | PT46B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| G15 | PT41A | 0 | | T | PT46A | 0 | | T |
| J14 | NC | - | | | PT45B | 0 | | C |
| L15 | NC | - | | | PT45A | 0 | | T |
| H14 | NC | - | | | PT44B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| K14 | NC | - | | | PT44A | 0 | | T |
| F15 | PT38B | 0 | | C | PT42B | 0 | | C |
| G14 | PT38A | 0 | | T | PT42A | 0 | | T |
| C15 | PT37B | 0 | | C | PT41B | 0 | | C |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| D14 | PT37A | 0 | | T | PT41A | 0 | | T |
| G13 | PT36B | 0 | | C | PT40B | 0 | | C |
| - | - | - | | | VCCIO0 | 0 | | |
| J13 | PT36A | 0 | | T | PT40A | 0 | | T |
| B14 | PT35B | 0 | | C | PT39B | 0 | | C |
| VCCIO | VCCIO0 | 0 | | | - | - | | |
| A14 | PT35A | 0 | | T | PT39A | 0 | | T |
| F13 | PT34B | 0 | | C | PT38B | 0 | | C |
| H13 | PT34A | 0 | | T | PT38A | 0 | | T |
| D13 | PT33B | 0 | | C | PT37B | 0 | | C |
| C14 | PT33A | 0 | | T | PT37A | 0 | | T |
| GNDIO | GNDIO0 | - | | | GNDIO0 | - | | |
| E13 | PT32B | 0 | | C | PT32B | 0 | | C |
| D12 | PT32A | 0 | | T | PT32A | 0 | | T |
| G12 | PT31B | 0 | | C | PT31B | 0 | | C |
| E12 | PT31A | 0 | | T | PT31A | 0 | | T |
| VCCIO | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| F12 | NC | - | | | PT30B | 0 | | C |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| D11 | NC | - | | | PT30A | 0 | | T |
| F11 | NC | - | | | PT29B | 0 | | C |
| E11 | NC | - | | | PT29A | 0 | | T |
| D7 | ULC_SQ_VCCRX0 | 11 | | | ULC_SQ_VCCRX0 | 11 | | |
| C9 | ULC_SQ_HDINP0 | 11 | | T | ULC_SQ_HDINP0 | 11 | | T |
| B9 | ULC_SQ_VCCIB0 | 11 | | | ULC_SQ_VCCIB0 | 11 | | |
| C8 | ULC_SQ_HDINN0 | 11 | | C | ULC_SQ_HDINN0 | 11 | | C |
| B8 | ULC_SQ_VCCTX0 | 11 | | | ULC_SQ_VCCTX0 | 11 | | |
| A9 | ULC_SQ_HDOUTP0 | 11 | | T | ULC_SQ_HDOUTP0 | 11 | | T |
| D9 | ULC_SQ_VCCOB0 | 11 | | | ULC_SQ_VCCOB0 | 11 | | |
| A8 | ULC_SQ_HDOUTN0 | 11 | | C | ULC_SQ_HDOUTN0 | 11 | | C |
| B7 | ULC_SQ_VCCTX1 | 11 | | | ULC_SQ_VCCTX1 | 11 | | |
| A7 | ULC_SQ_HDOUTN1 | 11 | | C | ULC_SQ_HDOUTN1 | 11 | | C |
| E7 | ULC_SQ_VCCOB1 | 11 | | | ULC_SQ_VCCOB1 | 11 | | |
| A6 | ULC_SQ_HDOUTP1 | 11 | | T | ULC_SQ_HDOUTP1 | 11 | | T |
| B6 | ULC_SQ_VCCRX1 | 11 | | | ULC_SQ_VCCRX1 | 11 | | |
| C7 | ULC_SQ_HDINN1 | 11 | | C | ULC_SQ_HDINN1 | 11 | | C |
| D8 | ULC_SQ_VCCIB1 | 11 | | | ULC_SQ_VCCIB1 | 11 | | |
| C6 | ULC_SQ_HDINP1 | 11 | | T | ULC_SQ_HDINP1 | 11 | | T |
| E6 | ULC_SQ_VCCAUX33 | 11 | | | ULC_SQ_VCCAUX33 | 11 | | |
| E5 | ULC_SQ_REFCLKN | 11 | | C | ULC_SQ_REFCLKN | 11 | | C |
| D5 | ULC_SQ_REFCLKP | 11 | | T | ULC_SQ_REFCLKP | 11 | | T |
| D6 | ULC_SQ_VCCP | 11 | | | ULC_SQ_VCCP | 11 | | |
| C5 | ULC_SQ_HDINP2 | 11 | | T | ULC_SQ_HDINP2 | 11 | | T |
| D4 | ULC_SQ_VCCIB2 | 11 | | | ULC_SQ_VCCIB2 | 11 | | |
| C4 | ULC_SQ_HDINN2 | 11 | | C | ULC_SQ_HDINN2 | 11 | | C |
| B5 | ULC_SQ_VCCRX2 | 11 | | | ULC_SQ_VCCRX2 | 11 | | |
| A5 | ULC_SQ_HDOUTP2 | 11 | | T | ULC_SQ_HDOUTP2 | 11 | | T |
| D3 | ULC_SQ_VCCOB2 | 11 | | | ULC_SQ_VCCOB2 | 11 | | |
| A4 | ULC_SQ_HDOUTN2 | 11 | | C | ULC_SQ_HDOUTN2 | 11 | | C |
| B4 | ULC_SQ_VCCTX2 | 11 | | | ULC_SQ_VCCTX2 | 11 | | |
| A3 | ULC_SQ_HDOUTN3 | 11 | | C | ULC_SQ_HDOUTN3 | 11 | | C |
| C1 | ULC_SQ_VCCOB3 | 11 | | | ULC_SQ_VCCOB3 | 11 | | |
| A2 | ULC_SQ_HDOUTP3 | 11 | | T | ULC_SQ_HDOUTP3 | 11 | | T |
| B3 | ULC_SQ_VCCTX3 | 11 | | | ULC_SQ_VCCTX3 | 11 | | |
| C3 | ULC_SQ_HDINN3 | 11 | | C | ULC_SQ_HDINN3 | 11 | | C |
| B1 | ULC_SQ_VCCIB3 | 11 | | | ULC_SQ_VCCIB3 | 11 | | |
| C2 | ULC_SQ_HDINP3 | 11 | | T | ULC_SQ_HDINP3 | 11 | | T |
| B2 | ULC_SQ_VCCRX3 | 11 | | | ULC_SQ_VCCRX3 | 11 | | |
| AA13 | VCC | - | | | VCC | - | | |
| AA14 | VCC | - | | | VCC | - | | |
| AA15 | VCC | - | | | VCC | - | | |
| AA16 | VCC | - | | | VCC | - | | |
| AA17 | VCC | - | | | VCC | - | | |
| AA18 | VCC | - | | | VCC | - | | |
| AA19 | VCC | - | | | VCC | - | | |
| AA20 | VCC | - | | | VCC | - | | |
| AA21 | VCC | - | | | VCC | - | | |
| AA22 | VCC | - | | | VCC | - | | |
| AB14 | VCC | - | | | VCC | - | | |
| AB15 | VCC | - | | | VCC | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AB20 | VCC | - | | | VCC | - | | |
| AB21 | VCC | - | | | VCC | - | | |
| N14 | VCC | - | | | VCC | - | | |
| N15 | VCC | - | | | VCC | - | | |
| N20 | VCC | - | | | VCC | - | | |
| N21 | VCC | - | | | VCC | - | | |
| P13 | VCC | - | | | VCC | - | | |
| P14 | VCC | - | | | VCC | - | | |
| P15 | VCC | - | | | VCC | - | | |
| P16 | VCC | - | | | VCC | - | | |
| P17 | VCC | - | | | VCC | - | | |
| P18 | VCC | - | | | VCC | - | | |
| P19 | VCC | - | | | VCC | - | | |
| P20 | VCC | - | | | VCC | - | | |
| P21 | VCC | - | | | VCC | - | | |
| P22 | VCC | - | | | VCC | - | | |
| R13 | VCC | - | | | VCC | - | | |
| R14 | VCC | - | | | VCC | - | | |
| R21 | VCC | - | | | VCC | - | | |
| R22 | VCC | - | | | VCC | - | | |
| T14 | VCC | - | | | VCC | - | | |
| T21 | VCC | - | | | VCC | - | | |
| U14 | VCC | - | | | VCC | - | | |
| U21 | VCC | - | | | VCC | - | | |
| V14 | VCC | - | | | VCC | - | | |
| V21 | VCC | - | | | VCC | - | | |
| W14 | VCC | - | | | VCC | - | | |
| W21 | VCC | - | | | VCC | - | | |
| Y13 | VCC | - | | | VCC | - | | |
| Y14 | VCC | - | | | VCC | - | | |
| Y21 | VCC | - | | | VCC | - | | |
| Y22 | VCC | - | | | VCC | - | | |
| C12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C16 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| E14 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H12 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| H16 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| M14 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| M15 | VCCIO0 | 0 | | | VCCIO0 | 0 | | |
| C19 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| C23 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| E21 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H19 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| H23 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| M20 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| M21 | VCCIO1 | 1 | | | VCCIO1 | 1 | | |
| G32 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K28 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| K32 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| N27 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| N32 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| P23 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| R23 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| T27 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| T32 | VCCIO2 | 2 | | | VCCIO2 | 2 | | |
| AA23 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AB27 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AB32 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AE28 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AE32 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AH32 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| W27 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| W32 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| Y23 | VCCIO3 | 3 | | | VCCIO3 | 3 | | |
| AC20 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC21 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AG19 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AG23 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AK21 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AM19 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AM23 | VCCIO4 | 4 | | | VCCIO4 | 4 | | |
| AC14 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AC15 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AG12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AG16 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AK14 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AM12 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AM16 | VCCIO5 | 5 | | | VCCIO5 | 5 | | |
| AA12 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AB3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AB8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AE3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AE7 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| AH3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W3 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| W8 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| Y12 | VCCIO6 | 6 | | | VCCIO6 | 6 | | |
| G3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| K7 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| N3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| N8 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| P12 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| R12 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| T3 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| T8 | VCCIO7 | 7 | | | VCCIO7 | 7 | | |
| AD28 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AG32 | VCCIO8 | 8 | | | VCCIO8 | 8 | | |
| AB12 | VCCAUX | - | | | VCCAUX | - | | |
| AB13 | VCCAUX | - | | | VCCAUX | - | | |
| AB22 | VCCAUX | - | | | VCCAUX | - | | |
| AB23 | VCCAUX | - | | | VCCAUX | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AC13 | VCCAUX | - | | | VCCAUX | - | | |
| AC22 | VCCAUX | - | | | VCCAUX | - | | |
| M13 | VCCAUX | - | | | VCCAUX | - | | |
| M22 | VCCAUX | - | | | VCCAUX | - | | |
| N12 | VCCAUX | - | | | VCCAUX | - | | |
| N13 | VCCAUX | - | | | VCCAUX | - | | |
| N22 | VCCAUX | - | | | VCCAUX | - | | |
| N23 | VCCAUX | - | | | VCCAUX | - | | |
| A1 | GND | - | | | GND | - | | |
| A10 | GND | - | | | GND | - | | |
| A13 | GND | - | | | GND | - | | |
| A22 | GND | - | | | GND | - | | |
| A25 | GND | - | | | GND | - | | |
| A34 | GND | - | | | GND | - | | |
| AB16 | GND | - | | | GND | - | | |
| AB17 | GND | - | | | GND | - | | |
| AB18 | GND | - | | | GND | - | | |
| AB19 | GND | - | | | GND | - | | |
| AB26 | GND | - | | | GND | - | | |
| AB31 | GND | - | | | GND | - | | |
| AB4 | GND | - | | | GND | - | | |
| AB9 | GND | - | | | GND | - | | |
| AC16 | GND | - | | | GND | - | | |
| AC17 | GND | - | | | GND | - | | |
| AC18 | GND | - | | | GND | - | | |
| AC19 | GND | - | | | GND | - | | |
| AD27 | GND | - | | | GND | - | | |
| AE27 | GND | - | | | GND | - | | |
| AE31 | GND | - | | | GND | - | | |
| AE4 | GND | - | | | GND | - | | |
| AE8 | GND | - | | | GND | - | | |
| AF12 | GND | - | | | GND | - | | |
| AF16 | GND | - | | | GND | - | | |
| AF19 | GND | - | | | GND | - | | |
| AF23 | GND | - | | | GND | - | | |
| AG31 | GND | - | | | GND | - | | |
| AH31 | GND | - | | | GND | - | | |
| AH4 | GND | - | | | GND | - | | |
| AJ14 | GND | - | | | GND | - | | |
| AJ21 | GND | - | | | GND | - | | |
| AK27 | GND | - | | | GND | - | | |
| AK8 | GND | - | | | GND | - | | |
| AL10 | GND | - | | | GND | - | | |
| AL16 | GND | - | | | GND | - | | |
| AL19 | GND | - | | | GND | - | | |
| AL2 | GND | - | | | GND | - | | |
| AL25 | GND | - | | | GND | - | | |
| AL33 | GND | - | | | GND | - | | |
| AP1 | GND | - | | | GND | - | | |
| AP10 | GND | - | | | GND | - | | |
| AP13 | GND | - | | | GND | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AP22 | GND | - | | | GND | - | | |
| AP25 | GND | - | | | GND | - | | |
| AP34 | GND | - | | | GND | - | | |
| D10 | GND | - | | | GND | - | | |
| D16 | GND | - | | | GND | - | | |
| D19 | GND | - | | | GND | - | | |
| D2 | GND | - | | | GND | - | | |
| D25 | GND | - | | | GND | - | | |
| D33 | GND | - | | | GND | - | | |
| E27 | GND | - | | | GND | - | | |
| E8 | GND | - | | | GND | - | | |
| F14 | GND | - | | | GND | - | | |
| F21 | GND | - | | | GND | - | | |
| G31 | GND | - | | | GND | - | | |
| G4 | GND | - | | | GND | - | | |
| J12 | GND | - | | | GND | - | | |
| J16 | GND | - | | | GND | - | | |
| J19 | GND | - | | | GND | - | | |
| J23 | GND | - | | | GND | - | | |
| K27 | GND | - | | | GND | - | | |
| K31 | GND | - | | | GND | - | | |
| K4 | GND | - | | | GND | - | | |
| K8 | GND | - | | | GND | - | | |
| M16 | GND | - | | | GND | - | | |
| M17 | GND | - | | | GND | - | | |
| M18 | GND | - | | | GND | - | | |
| M19 | GND | - | | | GND | - | | |
| N16 | GND | - | | | GND | - | | |
| N17 | GND | - | | | GND | - | | |
| N18 | GND | - | | | GND | - | | |
| N19 | GND | - | | | GND | - | | |
| N26 | GND | - | | | GND | - | | |
| N31 | GND | - | | | GND | - | | |
| N4 | GND | - | | | GND | - | | |
| N9 | GND | - | | | GND | - | | |
| R16 | GND | - | | | GND | - | | |
| R17 | GND | - | | | GND | - | | |
| R18 | GND | - | | | GND | - | | |
| R19 | GND | - | | | GND | - | | |
| T12 | GND | - | | | GND | - | | |
| T13 | GND | - | | | GND | - | | |
| T15 | GND | - | | | GND | - | | |
| T16 | GND | - | | | GND | - | | |
| T17 | GND | - | | | GND | - | | |
| T18 | GND | - | | | GND | - | | |
| T19 | GND | - | | | GND | - | | |
| T20 | GND | - | | | GND | - | | |
| T22 | GND | - | | | GND | - | | |
| T23 | GND | - | | | GND | - | | |
| T26 | GND | - | | | GND | - | | |
| T31 | GND | - | | | GND | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| T4 | GND | - | | | GND | - | | |
| T9 | GND | - | | | GND | - | | |
| U12 | GND | - | | | GND | - | | |
| U13 | GND | - | | | GND | - | | |
| U15 | GND | - | | | GND | - | | |
| U16 | GND | - | | | GND | - | | |
| U17 | GND | - | | | GND | - | | |
| U18 | GND | - | | | GND | - | | |
| U19 | GND | - | | | GND | - | | |
| U20 | GND | - | | | GND | - | | |
| U22 | GND | - | | | GND | - | | |
| U23 | GND | - | | | GND | - | | |
| V12 | GND | - | | | GND | - | | |
| V13 | GND | - | | | GND | - | | |
| V15 | GND | - | | | GND | - | | |
| V16 | GND | - | | | GND | - | | |
| V17 | GND | - | | | GND | - | | |
| V18 | GND | - | | | GND | - | | |
| V19 | GND | - | | | GND | - | | |
| V20 | GND | - | | | GND | - | | |
| V22 | GND | - | | | GND | - | | |
| V23 | GND | - | | | GND | - | | |
| W12 | GND | - | | | GND | - | | |
| W13 | GND | - | | | GND | - | | |
| W15 | GND | - | | | GND | - | | |
| W16 | GND | - | | | GND | - | | |
| W17 | GND | - | | | GND | - | | |
| W18 | GND | - | | | GND | - | | |
| W19 | GND | - | | | GND | - | | |
| W20 | GND | - | | | GND | - | | |
| W22 | GND | - | | | GND | - | | |
| W23 | GND | - | | | GND | - | | |
| W26 | GND | - | | | GND | - | | |
| W31 | GND | - | | | GND | - | | |
| W4 | GND | - | | | GND | - | | |
| W9 | GND | - | | | GND | - | | |
| Y16 | GND | - | | | GND | - | | |
| Y17 | GND | - | | | GND | - | | |
| Y18 | GND | - | | | GND | - | | |
| Y19 | GND | - | | | GND | - | | |
| A11 | NC | - | | | NC | - | | |
| A12 | NC | - | | | NC | - | | |
| A23 | NC | - | | | NC | - | | |
| A24 | NC | - | | | NC | - | | |
| AA11 | NC | - | | | NC | - | | |
| AB11 | NC | - | | | NC | - | | |
| AC26 | NC | - | | | NC | - | | |
| AC30 | NC | - | | | NC | - | | |
| AD11 | NC | - | | | NC | - | | |
| AD12 | NC | - | | | NC | - | | |
| AD13 | NC | - | | | NC | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AD14 | NC | - | | | NC | - | | |
| AD15 | NC | - | | | NC | - | | |
| AD19 | NC | - | | | NC | - | | |
| AD21 | NC | - | | | NC | - | | |
| AD22 | NC | - | | | NC | - | | |
| AD23 | NC | - | | | NC | - | | |
| AE10 | NC | - | | | NC | - | | |
| AE11 | NC | - | | | NC | - | | |
| AE12 | NC | - | | | NC | - | | |
| AE13 | NC | - | | | NC | - | | |
| AE19 | NC | - | | | NC | - | | |
| AE21 | NC | - | | | NC | - | | |
| AE22 | NC | - | | | NC | - | | |
| AE23 | NC | - | | | NC | - | | |
| AF11 | NC | - | | | NC | - | | |
| AF21 | NC | - | | | NC | - | | |
| AF22 | NC | - | | | NC | - | | |
| AF24 | NC | - | | | NC | - | | |
| AF8 | NC | - | | | NC | - | | |
| AF9 | NC | - | | | NC | - | | |
| AG10 | NC | - | | | NC | - | | |
| AG11 | NC | - | | | NC | - | | |
| AG24 | NC | - | | | NC | - | | |
| AG25 | NC | - | | | NC | - | | |
| AG26 | NC | - | | | NC | - | | |
| AG3 | NC | - | | | NC | - | | |
| AG7 | NC | - | | | NC | - | | |
| AG8 | NC | - | | | NC | - | | |
| AG9 | NC | - | | | NC | - | | |
| AH10 | NC | - | | | NC | - | | |
| AH11 | NC | - | | | NC | - | | |
| AH13 | NC | - | | | NC | - | | |
| AH24 | NC | - | | | NC | - | | |
| AH25 | NC | - | | | NC | - | | |
| AH26 | NC | - | | | NC | - | | |
| AH27 | NC | - | | | NC | - | | |
| AH5 | NC | - | | | NC | - | | |
| AH6 | NC | - | | | NC | - | | |
| AH7 | NC | - | | | NC | - | | |
| AH8 | NC | - | | | NC | - | | |
| AH9 | NC | - | | | NC | - | | |
| AJ10 | NC | - | | | NC | - | | |
| AJ11 | NC | - | | | NC | - | | |
| AJ13 | NC | - | | | NC | - | | |
| AJ24 | NC | - | | | NC | - | | |
| AJ25 | NC | - | | | NC | - | | |
| AJ26 | NC | - | | | NC | - | | |
| AJ27 | NC | - | | | NC | - | | |
| AJ3 | NC | - | | | NC | - | | |
| AJ4 | NC | - | | | NC | - | | |
| AJ5 | NC | - | | | NC | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| AJ6 | NC | - | | | NC | - | | |
| AJ7 | NC | - | | | NC | - | | |
| AJ8 | NC | - | | | NC | - | | |
| AJ9 | NC | - | | | NC | - | | |
| AK10 | NC | - | | | NC | - | | |
| AK11 | NC | - | | | NC | - | | |
| AK12 | NC | - | | | NC | - | | |
| AK24 | NC | - | | | NC | - | | |
| AK25 | NC | - | | | NC | - | | |
| AK26 | NC | - | | | NC | - | | |
| AK4 | NC | - | | | NC | - | | |
| AK9 | NC | - | | | NC | - | | |
| AL11 | NC | - | | | NC | - | | |
| AL12 | NC | - | | | NC | - | | |
| AL34 | NC | - | | | NC | - | | |
| AM10 | NC | - | | | NC | - | | |
| AM11 | NC | - | | | NC | - | | |
| AM13 | NC | - | | | NC | - | | |
| AM25 | NC | - | | | NC | - | | |
| AN10 | NC | - | | | NC | - | | |
| AN11 | NC | - | | | NC | - | | |
| AN12 | NC | - | | | NC | - | | |
| AN13 | NC | - | | | NC | - | | |
| AN24 | NC | - | | | NC | - | | |
| AN25 | NC | - | | | NC | - | | |
| AP11 | NC | - | | | NC | - | | |
| AP12 | NC | - | | | NC | - | | |
| AP24 | NC | - | | | NC | - | | |
| B10 | NC | - | | | NC | - | | |
| B11 | NC | - | | | NC | - | | |
| B12 | NC | - | | | NC | - | | |
| B13 | NC | - | | | NC | - | | |
| B22 | NC | - | | | NC | - | | |
| B23 | NC | - | | | NC | - | | |
| B24 | NC | - | | | NC | - | | |
| B25 | NC | - | | | NC | - | | |
| C10 | NC | - | | | NC | - | | |
| C11 | NC | - | | | NC | - | | |
| C13 | NC | - | | | NC | - | | |
| C22 | NC | - | | | NC | - | | |
| C24 | NC | - | | | NC | - | | |
| C25 | NC | - | | | NC | - | | |
| D1 | NC | - | | | NC | - | | |
| D15 | NC | - | | | NC | - | | |
| D24 | NC | - | | | NC | - | | |
| D34 | NC | - | | | NC | - | | |
| E10 | NC | - | | | NC | - | | |
| E24 | NC | - | | | NC | - | | |
| E25 | NC | - | | | NC | - | | |
| E26 | NC | - | | | NC | - | | |
| E3 | NC | - | | | NC | - | | |

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| E31 | NC | - | | | NC | - | | |
| E32 | NC | - | | | NC | - | | |
| E33 | NC | - | | | NC | - | | |
| E34 | NC | - | | | NC | - | | |
| E4 | NC | - | | | NC | - | | |
| E9 | NC | - | | | NC | - | | |
| F10 | NC | - | | | NC | - | | |
| F25 | NC | - | | | NC | - | | |
| F26 | NC | - | | | NC | - | | |
| F27 | NC | - | | | NC | - | | |
| F28 | NC | - | | | NC | - | | |
| F29 | NC | - | | | NC | - | | |
| F30 | NC | - | | | NC | - | | |
| F31 | NC | - | | | NC | - | | |
| F32 | NC | - | | | NC | - | | |
| F33 | NC | - | | | NC | - | | |
| F34 | NC | - | | | NC | - | | |
| F5 | NC | - | | | NC | - | | |
| F6 | NC | - | | | NC | - | | |
| F7 | NC | - | | | NC | - | | |
| F8 | NC | - | | | NC | - | | |
| F9 | NC | - | | | NC | - | | |
| G10 | NC | - | | | NC | - | | |
| G11 | NC | - | | | NC | - | | |
| G24 | NC | - | | | NC | - | | |
| G25 | NC | - | | | NC | - | | |
| G26 | NC | - | | | NC | - | | |
| G27 | NC | - | | | NC | - | | |
| G28 | NC | - | | | NC | - | | |
| G29 | NC | - | | | NC | - | | |
| G30 | NC | - | | | NC | - | | |
| G33 | NC | - | | | NC | - | | |
| G34 | NC | - | | | NC | - | | |
| G7 | NC | - | | | NC | - | | |
| G8 | NC | - | | | NC | - | | |
| G9 | NC | - | | | NC | - | | |
| H10 | NC | - | | | NC | - | | |
| H11 | NC | - | | | NC | - | | |
| H24 | NC | - | | | NC | - | | |
| H25 | NC | - | | | NC | - | | |
| H26 | NC | - | | | NC | - | | |
| H27 | NC | - | | | NC | - | | |
| H28 | NC | - | | | NC | - | | |
| H29 | NC | - | | | NC | - | | |
| H8 | NC | - | | | NC | - | | |
| H9 | NC | - | | | NC | - | | |
| J10 | NC | - | | | NC | - | | |
| J11 | NC | - | | | NC | - | | |
| J24 | NC | - | | | NC | - | | |
| J25 | NC | - | | | NC | - | | |
| J26 | NC | - | | | NC | - | | |

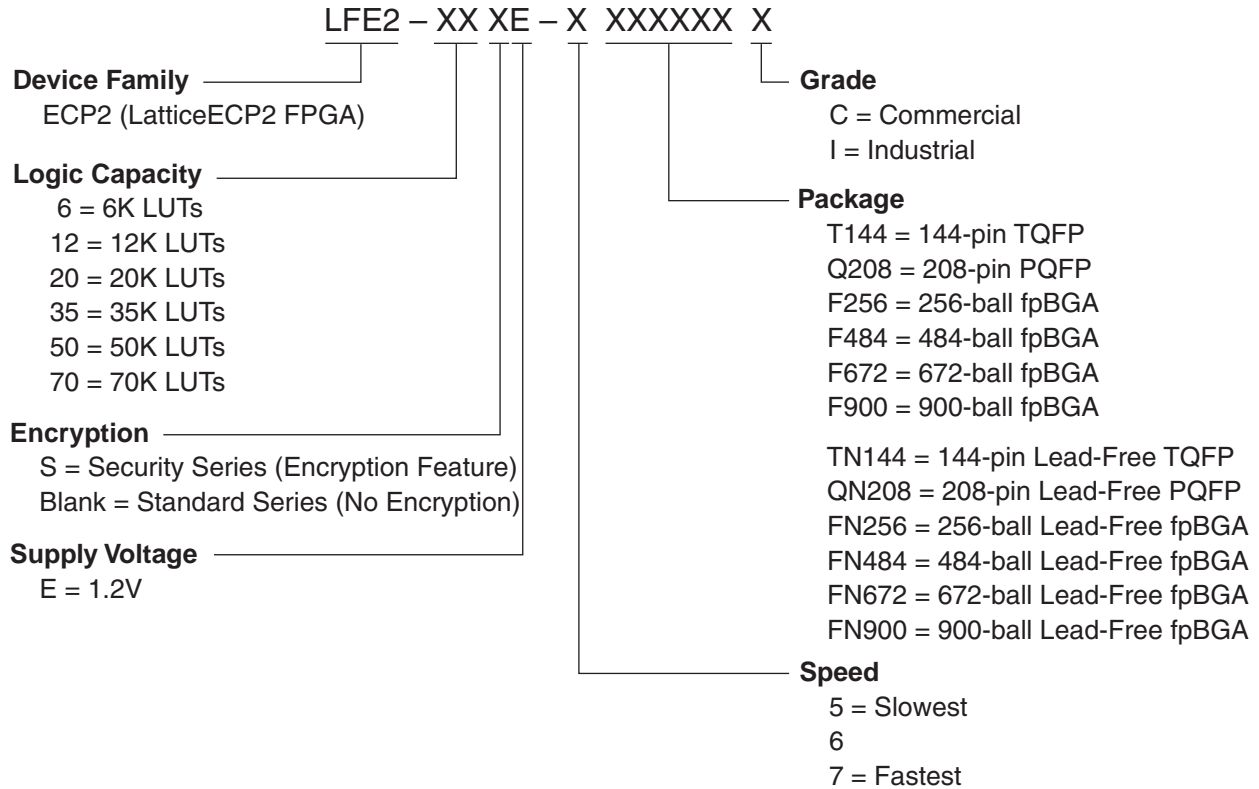
LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

| LFE2M70E/SE | | | | LFE2M100E/SE | | | | |
|-------------|-------------------|------|---------------|--------------|-------------------|------|---------------|--------------|
| Ball Number | Ball/Pad Function | Bank | Dual Function | Differential | Ball/Pad Function | Bank | Dual Function | Differential |
| J9 | NC | - | | | NC | - | | |
| K10 | NC | - | | | NC | - | | |
| K11 | NC | - | | | NC | - | | |
| K12 | NC | - | | | NC | - | | |
| K13 | NC | - | | | NC | - | | |
| K23 | NC | - | | | NC | - | | |
| K24 | NC | - | | | NC | - | | |
| K25 | NC | - | | | NC | - | | |
| K26 | NC | - | | | NC | - | | |
| L11 | NC | - | | | NC | - | | |
| L12 | NC | - | | | NC | - | | |
| L13 | NC | - | | | NC | - | | |
| L14 | NC | - | | | NC | - | | |
| L21 | NC | - | | | NC | - | | |
| L22 | NC | - | | | NC | - | | |
| L23 | NC | - | | | NC | - | | |
| L24 | NC | - | | | NC | - | | |
| L25 | NC | - | | | NC | - | | |
| L26 | NC | - | | | NC | - | | |
| M11 | NC | - | | | NC | - | | |
| M24 | NC | - | | | NC | - | | |
| M25 | NC | - | | | NC | - | | |
| M6 | NC | - | | | NC | - | | |
| M8 | NC | - | | | NC | - | | |
| N10 | NC | - | | | NC | - | | |
| N11 | NC | - | | | NC | - | | |
| P10 | NC | - | | | NC | - | | |
| P25 | NC | - | | | NC | - | | |
| P26 | NC | - | | | NC | - | | |
| R9 | NC | - | | | NC | - | | |
| T11 | NC | - | | | NC | - | | |
| U11 | NC | - | | | NC | - | | |
| W11 | NC | - | | | NC | - | | |
| Y10 | NC | - | | | NC | - | | |
| Y11 | NC | - | | | NC | - | | |
| R15 | VCCPLL | - | | | VCCPLL | - | | |
| R20 | VCCPLL | - | | | VCCPLL | - | | |
| Y15 | VCCPLL | - | | | VCCPLL | - | | |
| Y20 | VCCPLL | - | | | VCCPLL | - | | |

* Supports true LVDS. Other differential signals must be emulated with external resistors.
 ** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
 *** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).
 ****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

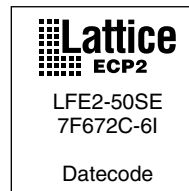
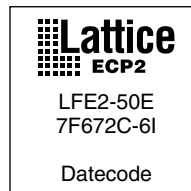
Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LatticeECP2 Part Number Description



Ordering Information

Note: LatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



LatticeECP2 Standard Series Devices, Conventional Packaging**Commercial**

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-6E-5T144C | 90 | 1.2V | -5 | TQFP | 144 | COM | 6 |
| LFE2-6E-6T144C | 90 | 1.2V | -6 | TQFP | 144 | COM | 6 |
| LFE2-6E-7T144C | 90 | 1.2V | -7 | TQFP | 144 | COM | 6 |
| LFE2-6E-5F256C | 190 | 1.2V | -5 | fpBGA | 256 | COM | 6 |
| LFE2-6E-6F256C | 190 | 1.2V | -6 | fpBGA | 256 | COM | 6 |
| LFE2-6E-7F256C | 190 | 1.2V | -7 | fpBGA | 256 | COM | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-12E-5T144C | 93 | 1.2V | -5 | TQFP | 144 | COM | 12 |
| LFE2-12E-6T144C | 93 | 1.2V | -6 | TQFP | 144 | COM | 12 |
| LFE2-12E-7T144C | 93 | 1.2V | -7 | TQFP | 144 | COM | 12 |
| LFE2-12E-5Q208C | 131 | 1.2V | -5 | PQFP | 208 | COM | 12 |
| LFE2-12E-6Q208C | 131 | 1.2V | -6 | PQFP | 208 | COM | 12 |
| LFE2-12E-7Q208C | 131 | 1.2V | -7 | PQFP | 208 | COM | 12 |
| LFE2-12E-5F256C | 193 | 1.2V | -5 | fpBGA | 256 | COM | 12 |
| LFE2-12E-6F256C | 193 | 1.2V | -6 | fpBGA | 256 | COM | 12 |
| LFE2-12E-7F256C | 193 | 1.2V | -7 | fpBGA | 256 | COM | 12 |
| LFE2-12E-5F484C | 297 | 1.2V | -5 | fpBGA | 484 | COM | 12 |
| LFE2-12E-6F484C | 297 | 1.2V | -6 | fpBGA | 484 | COM | 12 |
| LFE2-12E-7F484C | 297 | 1.2V | -7 | fpBGA | 484 | COM | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-20E-5Q208C | 131 | 1.2V | -5 | PQFP | 208 | COM | 20 |
| LFE2-20E-6Q208C | 131 | 1.2V | -6 | PQFP | 208 | COM | 20 |
| LFE2-20E-7Q208C | 131 | 1.2V | -7 | PQFP | 208 | COM | 20 |
| LFE2-20E-5F256C | 193 | 1.2V | -5 | fpBGA | 256 | COM | 20 |
| LFE2-20E-6F256C | 193 | 1.2V | -6 | fpBGA | 256 | COM | 20 |
| LFE2-20E-7F256C | 193 | 1.2V | -7 | fpBGA | 256 | COM | 20 |
| LFE2-20E-5F484C | 331 | 1.2V | -5 | fpBGA | 484 | COM | 20 |
| LFE2-20E-6F484C | 331 | 1.2V | -6 | fpBGA | 484 | COM | 20 |
| LFE2-20E-7F484C | 331 | 1.2V | -7 | fpBGA | 484 | COM | 20 |
| LFE2-20E-5F672C | 402 | 1.2V | -5 | fpBGA | 672 | COM | 20 |
| LFE2-20E-6F672C | 402 | 1.2V | -6 | fpBGA | 672 | COM | 20 |
| LFE2-20E-7F672C | 402 | 1.2V | -7 | fpBGA | 672 | COM | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-35E-5F484C | 331 | 1.2V | -5 | fpBGA | 484 | COM | 35 |
| LFE2-35E-6F484C | 331 | 1.2V | -6 | fpBGA | 484 | COM | 35 |
| LFE2-35E-7F484C | 331 | 1.2V | -7 | fpBGA | 484 | COM | 35 |
| LFE2-35E-5F672C | 450 | 1.2V | -5 | fpBGA | 672 | COM | 35 |
| LFE2-35E-6F672C | 450 | 1.2V | -6 | fpBGA | 672 | COM | 35 |
| LFE2-35E-7F672C | 450 | 1.2V | -7 | fpBGA | 672 | COM | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-50E-5F484C | 339 | 1.2V | -5 | fpBGA | 484 | COM | 50 |
| LFE2-50E-6F484C | 339 | 1.2V | -6 | fpBGA | 484 | COM | 50 |
| LFE2-50E-7F484C | 339 | 1.2V | -7 | fpBGA | 484 | COM | 50 |
| LFE2-50E-5F672C | 500 | 1.2V | -5 | fpBGA | 672 | COM | 50 |
| LFE2-50E-6F672C | 500 | 1.2V | -6 | fpBGA | 672 | COM | 50 |
| LFE2-50E-7F672C | 500 | 1.2V | -7 | fpBGA | 672 | COM | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-70E-5F672C | 500 | 1.2V | -5 | fpBGA | 672 | COM | 70 |
| LFE2-70E-6F672C | 500 | 1.2V | -6 | fpBGA | 672 | COM | 70 |
| LFE2-70E-7F672C | 500 | 1.2V | -7 | fpBGA | 672 | COM | 70 |
| LFE2-70E-5F900C | 583 | 1.2V | -5 | fpBGA | 900 | COM | 70 |
| LFE2-70E-6F900C | 583 | 1.2V | -6 | fpBGA | 900 | COM | 70 |
| LFE2-70E-7F900C | 583 | 1.2V | -7 | fpBGA | 900 | COM | 70 |

Industrial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-6E-5T144I | 90 | 1.2V | -5 | TQFP | 144 | IND | 6 |
| LFE2-6E-6T144I | 90 | 1.2V | -6 | TQFP | 144 | IND | 6 |
| LFE2-6E-5F256I | 190 | 1.2V | -5 | fpBGA | 256 | IND | 6 |
| LFE2-6E-6F256I | 190 | 1.2V | -6 | fpBGA | 256 | IND | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-12E-5T144I | 93 | 1.2V | -5 | TQFP | 144 | IND | 12 |
| LFE2-12E-6T144I | 93 | 1.2V | -6 | TQFP | 144 | IND | 12 |
| LFE2-12E-5Q208I | 131 | 1.2V | -5 | PQFP | 208 | IND | 12 |
| LFE2-12E-6Q208I | 131 | 1.2V | -6 | PQFP | 208 | IND | 12 |
| LFE2-12E-5F256I | 193 | 1.2V | -5 | fpBGA | 256 | IND | 12 |
| LFE2-12E-6F256I | 193 | 1.2V | -6 | fpBGA | 256 | IND | 12 |
| LFE2-12E-5F484I | 297 | 1.2V | -5 | fpBGA | 484 | IND | 12 |
| LFE2-12E-6F484I | 297 | 1.2V | -6 | fpBGA | 484 | IND | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-20E-5Q208I | 131 | 1.2V | -5 | PQFP | 208 | IND | 20 |
| LFE2-20E-6Q208I | 131 | 1.2V | -6 | PQFP | 208 | IND | 20 |
| LFE2-20E-5F256I | 193 | 1.2V | -5 | fpBGA | 256 | IND | 20 |
| LFE2-20E-6F256I | 193 | 1.2V | -6 | fpBGA | 256 | IND | 20 |
| LFE2-20E-5F484I | 331 | 1.2V | -5 | fpBGA | 484 | IND | 20 |
| LFE2-20E-6F484I | 331 | 1.2V | -6 | fpBGA | 484 | IND | 20 |
| LFE2-20E-5F672I | 402 | 1.2V | -5 | fpBGA | 672 | IND | 20 |
| LFE2-20E-6F672I | 402 | 1.2V | -6 | fpBGA | 672 | IND | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-35E-5F484I | 331 | 1.2V | -5 | fpBGA | 484 | IND | 35 |
| LFE2-35E-6F484I | 331 | 1.2V | -6 | fpBGA | 484 | IND | 35 |
| LFE2-35E-5F672I | 450 | 1.2V | -5 | fpBGA | 672 | IND | 35 |
| LFE2-35E-6F672I | 450 | 1.2V | -6 | fpBGA | 672 | IND | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-50E-5F484I | 339 | 1.2V | -5 | fpBGA | 484 | IND | 50 |
| LFE2-50E-6F484I | 339 | 1.2V | -6 | fpBGA | 484 | IND | 50 |
| LFE2-50E-5F672I | 500 | 1.2V | -5 | fpBGA | 672 | IND | 50 |
| LFE2-50E-6F672I | 500 | 1.2V | -6 | fpBGA | 672 | IND | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-70E-5F672I | 500 | 1.2V | -5 | fpBGA | 672 | IND | 70 |
| LFE2-70E-6F672I | 500 | 1.2V | -6 | fpBGA | 672 | IND | 70 |
| LFE2-70E-5F900I | 583 | 1.2V | -5 | fpBGA | 900 | IND | 70 |
| LFE2-70E-6F900I | 583 | 1.2V | -6 | fpBGA | 900 | IND | 70 |

LatticeECP2 Standard Series Devices, Lead-Free Packaging**Commercial**

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-6E-5TN144C | 90 | 1.2V | -5 | Lead-Free TQFP | 144 | COM | 6 |
| LFE2-6E-6TN144C | 90 | 1.2V | -6 | Lead-Free TQFP | 144 | COM | 6 |
| LFE2-6E-7TN144C | 90 | 1.2V | -7 | Lead-Free TQFP | 144 | COM | 6 |
| LFE2-6E-5FN256C | 190 | 1.2V | -5 | Lead-Free fpBGA | 256 | COM | 6 |
| LFE2-6E-6FN256C | 190 | 1.2V | -6 | Lead-Free fpBGA | 256 | COM | 6 |
| LFE2-6E-7FN256C | 190 | 1.2V | -7 | Lead-Free fpBGA | 256 | COM | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-12E-5TN144C | 93 | 1.2V | -5 | Lead-Free TQFP | 144 | COM | 12 |
| LFE2-12E-6TN144C | 93 | 1.2V | -6 | Lead-Free TQFP | 144 | COM | 12 |
| LFE2-12E-7TN144C | 93 | 1.2V | -7 | Lead-Free TQFP | 144 | COM | 12 |
| LFE2-12E-5QN208C | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | COM | 12 |
| LFE2-12E-6QN208C | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | COM | 12 |
| LFE2-12E-7QN208C | 131 | 1.2V | -7 | Lead-Free PQFP | 208 | COM | 12 |
| LFE2-12E-5FN256C | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | COM | 12 |
| LFE2-12E-6FN256C | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | COM | 12 |
| LFE2-12E-7FN256C | 193 | 1.2V | -7 | Lead-Free fpBGA | 256 | COM | 12 |
| LFE2-12E-5FN484C | 297 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 12 |
| LFE2-12E-6FN484C | 297 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 12 |
| LFE2-12E-7FN484C | 297 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-20E-5QN208C | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | COM | 20 |
| LFE2-20E-6QN208C | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | COM | 20 |
| LFE2-20E-7QN208C | 131 | 1.2V | -7 | Lead-Free PQFP | 208 | COM | 20 |
| LFE2-20E-5FN256C | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | COM | 20 |
| LFE2-20E-6FN256C | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | COM | 20 |
| LFE2-20E-7FN256C | 193 | 1.2V | -7 | Lead-Free fpBGA | 256 | COM | 20 |
| LFE2-20E-5FN484C | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 20 |
| LFE2-20E-6FN484C | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 20 |
| LFE2-20E-7FN484C | 331 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 20 |
| LFE2-20E-5FN672C | 402 | 1.2V | -5 | Lead-Free fpBGA | 672 | COM | 20 |
| LFE2-20E-6FN672C | 402 | 1.2V | -6 | Lead-Free fpBGA | 672 | COM | 20 |
| LFE2-20E-7FN672C | 402 | 1.2V | -7 | Lead-Free fpBGA | 672 | COM | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-35E-5FN484C | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 35 |
| LFE2-35E-6FN484C | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 35 |
| LFE2-35E-7FN484C | 331 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 35 |
| LFE2-35E-5FN672C | 450 | 1.2V | -5 | Lead-Free fpBGA | 672 | COM | 35 |
| LFE2-35E-6FN672C | 450 | 1.2V | -6 | Lead-Free fpBGA | 672 | COM | 35 |
| LFE2-35E-7FN672C | 450 | 1.2V | -7 | Lead-Free fpBGA | 672 | COM | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-50E-5FN484C | 339 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 50 |
| LFE2-50E-6FN484C | 339 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 50 |
| LFE2-50E-7FN484C | 339 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 50 |
| LFE2-50E-5FN672C | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | COM | 50 |
| LFE2-50E-6FN672C | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | COM | 50 |
| LFE2-50E-7FN672C | 500 | 1.2V | -7 | Lead-Free fpBGA | 672 | COM | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-70E-5FN672C | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | COM | 70 |
| LFE2-70E-6FN672C | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | COM | 70 |
| LFE2-70E-7FN672C | 500 | 1.2V | -7 | Lead-Free fpBGA | 672 | COM | 70 |
| LFE2-70E-5FN900C | 583 | 1.2V | -5 | Lead-Free fpBGA | 900 | COM | 70 |
| LFE2-70E-6FN900C | 583 | 1.2V | -6 | Lead-Free fpBGA | 900 | COM | 70 |
| LFE2-70E-7FN900C | 583 | 1.2V | -7 | Lead-Free fpBGA | 900 | COM | 70 |

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| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-6E-5TN144I | 90 | 1.2V | -5 | Lead-Free TQFP | 144 | IND | 6 |
| LFE2-6E-6TN144I | 90 | 1.2V | -6 | Lead-Free TQFP | 144 | IND | 6 |
| LFE2-6E-5FN256I | 190 | 1.2V | -5 | Lead-Free fpBGA | 256 | IND | 6 |
| LFE2-6E-6FN256I | 190 | 1.2V | -6 | Lead-Free fpBGA | 256 | IND | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-12E-5TN144I | 93 | 1.2V | -5 | Lead-Free TQFP | 144 | IND | 12 |
| LFE2-12E-6TN144I | 93 | 1.2V | -6 | Lead-Free TQFP | 144 | IND | 12 |
| LFE2-12E-5QN208I | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | IND | 12 |
| LFE2-12E-6QN208I | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | IND | 12 |
| LFE2-12E-5FN256I | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | IND | 12 |
| LFE2-12E-6FN256I | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | IND | 12 |
| LFE2-12E-5FN484I | 297 | 1.2V | -5 | Lead-Free fpBGA | 484 | IND | 12 |
| LFE2-12E-6FN484I | 297 | 1.2V | -6 | Lead-Free fpBGA | 484 | IND | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-20E-5QN208I | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | IND | 20 |
| LFE2-20E-6QN208I | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | IND | 20 |
| LFE2-20E-5FN256I | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | IND | 20 |
| LFE2-20E-6FN256I | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | IND | 20 |
| LFE2-20E-5FN484I | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | IND | 20 |
| LFE2-20E-6FN484I | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | IND | 20 |
| LFE2-20E-5FN672I | 402 | 1.2V | -5 | Lead-Free fpBGA | 672 | IND | 20 |
| LFE2-20E-6FN672I | 402 | 1.2V | -6 | Lead-Free fpBGA | 672 | IND | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-35E-5FN484I | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | IND | 35 |
| LFE2-35E-6FN484I | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | IND | 35 |
| LFE2-35E-5FN672I | 450 | 1.2V | -5 | Lead-Free fpBGA | 672 | IND | 35 |
| LFE2-35E-6FN672I | 450 | 1.2V | -6 | Lead-Free fpBGA | 672 | IND | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-50E-5FN484I | 339 | 1.2V | -5 | Lead-Free fpBGA | 484 | IND | 50 |
| LFE2-50E-6FN484I | 339 | 1.2V | -6 | Lead-Free fpBGA | 484 | IND | 50 |
| LFE2-50E-5FN672I | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | IND | 50 |
| LFE2-50E-6FN672I | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | IND | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-70E-5FN672I | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | IND | 70 |
| LFE2-70E-6FN672I | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | IND | 70 |
| LFE2-70E-5FN900I | 583 | 1.2V | -5 | Lead-Free fpBGA | 900 | IND | 70 |
| LFE2-70E-6FN900I | 583 | 1.2V | -6 | Lead-Free fpBGA | 900 | IND | 70 |

LatticeECP2 S-Series Devices, Conventional Packaging**Commercial**

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-6SE-5T144C | 90 | 1.2V | -5 | TQFP | 144 | Com | 6 |
| LFE2-6SE-6T144C | 90 | 1.2V | -6 | TQFP | 144 | Com | 6 |
| LFE2-6SE-7T144C | 90 | 1.2V | -7 | TQFP | 144 | Com | 6 |
| LFE2-6SE-5F256C | 190 | 1.2V | -5 | fpBGA | 256 | Com | 6 |
| LFE2-6SE-6F256C | 190 | 1.2V | -6 | fpBGA | 256 | Com | 6 |
| LFE2-6SE-7F256C | 190 | 1.2V | -7 | fpBGA | 256 | Com | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-12SE-5T144C | 93 | 1.2V | -5 | TQFP | 144 | Com | 12 |
| LFE2-12SE-6T144C | 93 | 1.2V | -6 | TQFP | 144 | Com | 12 |
| LFE2-12SE-7T144C | 93 | 1.2V | -7 | TQFP | 144 | Com | 12 |
| LFE2-12SE-5Q208C | 131 | 1.2V | -5 | PQFP | 208 | Com | 12 |
| LFE2-12SE-6Q208C | 131 | 1.2V | -6 | PQFP | 208 | Com | 12 |
| LFE2-12SE-7Q208C | 131 | 1.2V | -7 | PQFP | 208 | Com | 12 |
| LFE2-12SE-5F256C | 193 | 1.2V | -5 | fpBGA | 256 | Com | 12 |
| LFE2-12SE-6F256C | 193 | 1.2V | -6 | fpBGA | 256 | Com | 12 |
| LFE2-12SE-7F256C | 193 | 1.2V | -7 | fpBGA | 256 | Com | 12 |
| LFE2-12SE-5F484C | 297 | 1.2V | -5 | fpBGA | 484 | Com | 12 |
| LFE2-12SE-6F484C | 297 | 1.2V | -6 | fpBGA | 484 | Com | 12 |
| LFE2-12SE-7F484C | 297 | 1.2V | -7 | fpBGA | 484 | Com | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-20SE-5Q208C | 131 | 1.2V | -5 | PQFP | 208 | Com | 20 |
| LFE2-20SE-6Q208C | 131 | 1.2V | -6 | PQFP | 208 | Com | 20 |
| LFE2-20SE-7Q208C | 131 | 1.2V | -7 | PQFP | 208 | Com | 20 |
| LFE2-20SE-5F256C | 193 | 1.2V | -5 | fpBGA | 256 | Com | 20 |
| LFE2-20SE-6F256C | 193 | 1.2V | -6 | fpBGA | 256 | Com | 20 |
| LFE2-20SE-7F256C | 193 | 1.2V | -7 | fpBGA | 256 | Com | 20 |
| LFE2-20SE-5F484C | 331 | 1.2V | -5 | fpBGA | 484 | Com | 20 |
| LFE2-20SE-6F484C | 331 | 1.2V | -6 | fpBGA | 484 | Com | 20 |
| LFE2-20SE-7F484C | 331 | 1.2V | -7 | fpBGA | 484 | Com | 20 |
| LFE2-20SE-5F672C | 402 | 1.2V | -5 | fpBGA | 672 | Com | 20 |
| LFE2-20SE-6F672C | 402 | 1.2V | -6 | fpBGA | 672 | Com | 20 |
| LFE2-20SE-7F672C | 402 | 1.2V | -7 | fpBGA | 672 | Com | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-35SE-5F484C | 331 | 1.2V | -5 | fpBGA | 484 | Com | 35 |
| LFE2-35SE-6F484C | 331 | 1.2V | -6 | fpBGA | 484 | Com | 35 |
| LFE2-35SE-7F484C | 331 | 1.2V | -7 | fpBGA | 484 | Com | 35 |
| LFE2-35SE-5F672C | 450 | 1.2V | -5 | fpBGA | 672 | Com | 35 |
| LFE2-35SE-6F672C | 450 | 1.2V | -6 | fpBGA | 672 | Com | 35 |
| LFE2-35SE-7F672C | 450 | 1.2V | -7 | fpBGA | 672 | Com | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-50SE-5F484C | 339 | 1.2V | -5 | fpBGA | 484 | Com | 50 |
| LFE2-50SE-6F484C | 339 | 1.2V | -6 | fpBGA | 484 | Com | 50 |
| LFE2-50SE-7F484C | 339 | 1.2V | -7 | fpBGA | 484 | Com | 50 |
| LFE2-50SE-5F672C | 500 | 1.2V | -5 | fpBGA | 672 | Com | 50 |
| LFE2-50SE-6F672C | 500 | 1.2V | -6 | fpBGA | 672 | Com | 50 |
| LFE2-50SE-7F672C | 500 | 1.2V | -7 | fpBGA | 672 | Com | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-70SE-5F672C | 500 | 1.2V | -5 | fpBGA | 672 | Com | 70 |
| LFE2-70SE-6F672C | 500 | 1.2V | -6 | fpBGA | 672 | Com | 70 |
| LFE2-70SE-7F672C | 500 | 1.2V | -7 | fpBGA | 672 | Com | 70 |
| LFE2-70SE-5F900C | 583 | 1.2V | -5 | fpBGA | 900 | Com | 70 |
| LFE2-70SE-6F900C | 583 | 1.2V | -6 | fpBGA | 900 | Com | 70 |
| LFE2-70SE-7F900C | 583 | 1.2V | -7 | fpBGA | 900 | Com | 70 |

Industrial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2-6SE-5T144I | 90 | 1.2V | -5 | TQFP | 144 | Ind | 6 |
| LFE2-6SE-6T144I | 90 | 1.2V | -6 | TQFP | 144 | Ind | 6 |
| LFE2-6SE-5F256I | 190 | 1.2V | -5 | fpBGA | 256 | Ind | 6 |
| LFE2-6SE-6F256I | 190 | 1.2V | -6 | fpBGA | 256 | Ind | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-12SE-5T144I | 93 | 1.2V | -5 | TQFP | 144 | Ind | 12 |
| LFE2-12SE-6T144I | 93 | 1.2V | -6 | TQFP | 144 | Ind | 12 |
| LFE2-12SE-5Q208I | 131 | 1.2V | -5 | PQFP | 208 | Ind | 12 |
| LFE2-12SE-6Q208I | 131 | 1.2V | -6 | PQFP | 208 | Ind | 12 |
| LFE2-12SE-5F256I | 193 | 1.2V | -5 | fpBGA | 256 | Ind | 12 |
| LFE2-12SE-6F256I | 193 | 1.2V | -6 | fpBGA | 256 | Ind | 12 |
| LFE2-12SE-5F484I | 297 | 1.2V | -5 | fpBGA | 484 | Ind | 12 |
| LFE2-12SE-6F484I | 297 | 1.2V | -6 | fpBGA | 484 | Ind | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-20SE-5Q208I | 131 | 1.2V | -5 | PQFP | 208 | Ind | 20 |
| LFE2-20SE-6Q208I | 131 | 1.2V | -6 | PQFP | 208 | Ind | 20 |
| LFE2-20SE-5F256I | 193 | 1.2V | -5 | fpBGA | 256 | Ind | 20 |
| LFE2-20SE-6F256I | 193 | 1.2V | -6 | fpBGA | 256 | Ind | 20 |
| LFE2-20SE-5F484I | 331 | 1.2V | -5 | fpBGA | 484 | Ind | 20 |
| LFE2-20SE-6F484I | 331 | 1.2V | -6 | fpBGA | 484 | Ind | 20 |
| LFE2-20SE-5F672I | 402 | 1.2V | -5 | fpBGA | 672 | Ind | 20 |
| LFE2-20SE-6F672I | 402 | 1.2V | -6 | fpBGA | 672 | Ind | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-35SE-5F484I | 331 | 1.2V | -5 | fpBGA | 484 | Ind | 35 |
| LFE2-35SE-6F484I | 331 | 1.2V | -6 | fpBGA | 484 | Ind | 35 |
| LFE2-35SE-5F672I | 450 | 1.2V | -5 | fpBGA | 672 | Ind | 35 |
| LFE2-35SE-6F672I | 450 | 1.2V | -6 | fpBGA | 672 | Ind | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-50SE-5F484I | 339 | 1.2V | -5 | fpBGA | 484 | Ind | 50 |
| LFE2-50SE-6F484I | 339 | 1.2V | -6 | fpBGA | 484 | Ind | 50 |
| LFE2-50SE-5F672I | 500 | 1.2V | -5 | fpBGA | 672 | Ind | 50 |
| LFE2-50SE-6F672I | 500 | 1.2V | -6 | fpBGA | 672 | Ind | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2-70SE-5F672I | 500 | 1.2V | -5 | fpBGA | 672 | Ind | 70 |
| LFE2-70SE-6F672I | 500 | 1.2V | -6 | fpBGA | 672 | Ind | 70 |
| LFE2-70SE-5F900I | 583 | 1.2V | -5 | fpBGA | 900 | Ind | 70 |
| LFE2-70SE-6F900I | 583 | 1.2V | -6 | fpBGA | 900 | Ind | 70 |

LatticeECP2 S-Series Devices, Lead-Free Packaging**Commercial**

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-6SE-5TN144C | 90 | 1.2V | -5 | Lead-Free TQFP | 144 | Com | 6 |
| LFE2-6SE-6TN144C | 90 | 1.2V | -6 | Lead-Free TQFP | 144 | Com | 6 |
| LFE2-6SE-7TN144C | 90 | 1.2V | -7 | Lead-Free TQFP | 144 | Com | 6 |
| LFE2-6SE-5FN256C | 190 | 1.2V | -5 | Lead-Free fpBGA | 256 | Com | 6 |
| LFE2-6SE-6FN256C | 190 | 1.2V | -6 | Lead-Free fpBGA | 256 | Com | 6 |
| LFE2-6SE-7FN256C | 190 | 1.2V | -7 | Lead-Free fpBGA | 256 | Com | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-12SE-5TN144C | 93 | 1.2V | -5 | Lead-Free TQFP | 144 | Com | 12 |
| LFE2-12SE-6TN144C | 93 | 1.2V | -6 | Lead-Free TQFP | 144 | Com | 12 |
| LFE2-12SE-7TN144C | 93 | 1.2V | -7 | Lead-Free TQFP | 144 | Com | 12 |
| LFE2-12SE-5QN208C | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | Com | 12 |
| LFE2-12SE-6QN208C | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | Com | 12 |
| LFE2-12SE-7QN208C | 131 | 1.2V | -7 | Lead-Free PQFP | 208 | Com | 12 |
| LFE2-12SE-5FN256C | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | Com | 12 |
| LFE2-12SE-6FN256C | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | Com | 12 |
| LFE2-12SE-7FN256C | 193 | 1.2V | -7 | Lead-Free fpBGA | 256 | Com | 12 |
| LFE2-12SE-5FN484C | 297 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 12 |
| LFE2-12SE-6FN484C | 297 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 12 |
| LFE2-12SE-7FN484C | 297 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-20SE-5QN208C | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | Com | 20 |
| LFE2-20SE-6QN208C | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | Com | 20 |
| LFE2-20SE-7QN208C | 131 | 1.2V | -7 | Lead-Free PQFP | 208 | Com | 20 |
| LFE2-20SE-5FN256C | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | Com | 20 |
| LFE2-20SE-6FN256C | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | Com | 20 |
| LFE2-20SE-7FN256C | 193 | 1.2V | -7 | Lead-Free fpBGA | 256 | Com | 20 |
| LFE2-20SE-5FN484C | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 20 |
| LFE2-20SE-6FN484C | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 20 |
| LFE2-20SE-7FN484C | 331 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 20 |
| LFE2-20SE-5FN672C | 402 | 1.2V | -5 | Lead-Free fpBGA | 672 | Com | 20 |
| LFE2-20SE-6FN672C | 402 | 1.2V | -6 | Lead-Free fpBGA | 672 | Com | 20 |
| LFE2-20SE-7FN672C | 402 | 1.2V | -7 | Lead-Free fpBGA | 672 | Com | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-35SE-5FN484C | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 35 |
| LFE2-35SE-6FN484C | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 35 |
| LFE2-35SE-7FN484C | 331 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 35 |
| LFE2-35SE-5FN672C | 450 | 1.2V | -5 | Lead-Free fpBGA | 672 | Com | 35 |
| LFE2-35SE-6FN672C | 450 | 1.2V | -6 | Lead-Free fpBGA | 672 | Com | 35 |
| LFE2-35SE-7FN672C | 450 | 1.2V | -7 | Lead-Free fpBGA | 672 | Com | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-50SE-5FN484C | 339 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 50 |
| LFE2-50SE-6FN484C | 339 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 50 |
| LFE2-50SE-7FN484C | 339 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 50 |
| LFE2-50SE-5FN672C | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | Com | 50 |
| LFE2-50SE-6FN672C | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | Com | 50 |
| LFE2-50SE-7FN672C | 500 | 1.2V | -7 | Lead-Free fpBGA | 672 | Com | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-70SE-5FN672C | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | Com | 70 |
| LFE2-70SE-6FN672C | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | Com | 70 |
| LFE2-70SE-7FN672C | 500 | 1.2V | -7 | Lead-Free fpBGA | 672 | Com | 70 |
| LFE2-70SE-5FN900C | 583 | 1.2V | -5 | Lead-Free fpBGA | 900 | Com | 70 |
| LFE2-70SE-6FN900C | 583 | 1.2V | -6 | Lead-Free fpBGA | 900 | Com | 70 |
| LFE2-70SE-7FN900C | 583 | 1.2V | -7 | Lead-Free fpBGA | 900 | Com | 70 |

Industrial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-6SE-5TN144I | 90 | 1.2V | -5 | Lead-Free TQFP | 144 | Ind | 6 |
| LFE2-6SE-6TN144I | 90 | 1.2V | -6 | Lead-Free TQFP | 144 | Ind | 6 |
| LFE2-6SE-5FN256I | 190 | 1.2V | -5 | Lead-Free fpBGA | 256 | Ind | 6 |
| LFE2-6SE-6FN256I | 190 | 1.2V | -6 | Lead-Free fpBGA | 256 | Ind | 6 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-12SE-5TN144I | 93 | 1.2V | -5 | Lead-Free TQFP | 144 | Ind | 12 |
| LFE2-12SE-6TN144I | 93 | 1.2V | -6 | Lead-Free TQFP | 144 | Ind | 12 |
| LFE2-12SE-5QN208I | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | Ind | 12 |
| LFE2-12SE-6QN208I | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | Ind | 12 |
| LFE2-12SE-5FN256I | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | Ind | 12 |
| LFE2-12SE-6FN256I | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | Ind | 12 |
| LFE2-12SE-5FN484I | 297 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 12 |
| LFE2-12SE-6FN484I | 297 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 12 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-20SE-5QN208I | 131 | 1.2V | -5 | Lead-Free PQFP | 208 | Ind | 20 |
| LFE2-20SE-6QN208I | 131 | 1.2V | -6 | Lead-Free PQFP | 208 | Ind | 20 |
| LFE2-20SE-5FN256I | 193 | 1.2V | -5 | Lead-Free fpBGA | 256 | Ind | 20 |
| LFE2-20SE-6FN256I | 193 | 1.2V | -6 | Lead-Free fpBGA | 256 | Ind | 20 |
| LFE2-20SE-5FN484I | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 20 |
| LFE2-20SE-6FN484I | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 20 |
| LFE2-20SE-5FN672I | 402 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 20 |
| LFE2-20SE-6FN672I | 402 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-35SE-5FN484I | 331 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 35 |
| LFE2-35SE-6FN484I | 331 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 35 |
| LFE2-35SE-5FN672I | 450 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 35 |
| LFE2-35SE-6FN672I | 450 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-50SE-5FN484I | 339 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 50 |
| LFE2-50SE-6FN484I | 339 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 50 |
| LFE2-50SE-5FN672I | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 50 |
| LFE2-50SE-6FN672I | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2-70SE-5FN672I | 500 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 70 |
| LFE2-70SE-6FN672I | 500 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 70 |
| LFE2-70SE-5FN900I | 583 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 70 |
| LFE2-70SE-6FN900I | 583 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 70 |

LatticeECP2M Part Number Description

LFE2M XXX XE - X XXXXXX X

Device Family

ECP2M (LatticeECP2 FPGA + SERDES)

Logic Capacity

- 20 = 20K LUTs
- 35 = 35K LUTs
- 50 = 50K LUTs
- 70 = 70K LUTs
- 100 = 100K LUTs

Encryption

- S = Security Series (Encryption Feature)
- Blank = Standard Series (No Encryption)

Supply Voltage

E = 1.2V

Grade

- C = Commercial
- I = Industrial

Package

- F256 = 256-ball fpBGA
- F484 = 484-ball fpBGA
- F672 = 672-ball fpBGA
- F900 = 900-ball fpBGA
- F1152 = 1152-ball fpBGA

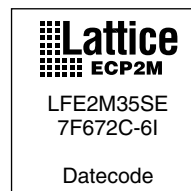
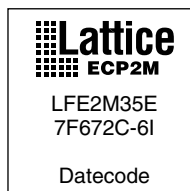
- FN256 = 256-ball Lead-free fpBGA
- FN484 = 484-ball Lead-free fpBGA
- FN672 = 672-ball Lead-free fpBGA
- FN900 = 900-ball Lead-free fpBGA
- FN1152 = 1152-ball Lead-free fpBGA

Speed

- 5 = Slowest
- 6
- 7 = Fastest

Ordering Information

Note: LatticeECP2M devices are dual marked. For example, the commercial speed grade LFE2M50E-7F672C is also marked with industrial grade -6I (LFE2M50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial grade does not have industrial markings. The markings appear as follows:



LatticeECP2M Standard Series Devices, Conventional Packaging**Commercial**

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2M20E-5F484C | 304 | 1.2V | -5 | fpBGA | 484 | COM | 20 |
| LFE2M20E-6F484C | 304 | 1.2V | -6 | fpBGA | 484 | COM | 20 |
| LFE2M20E-7F484C | 304 | 1.2V | -7 | fpBGA | 484 | COM | 20 |
| LFE2M20E-5F256C | 140 | 1.2V | -5 | fpBGA | 256 | COM | 20 |
| LFE2M20E-6F256C | 140 | 1.2V | -6 | fpBGA | 256 | COM | 20 |
| LFE2M20E-7F256C | 140 | 1.2V | -7 | fpBGA | 256 | COM | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2M35E-5F672C | 410 | 1.2V | -5 | fpBGA | 672 | COM | 35 |
| LFE2M35E-6F672C | 410 | 1.2V | -6 | fpBGA | 672 | COM | 35 |
| LFE2M35E-7F672C | 410 | 1.2V | -7 | fpBGA | 672 | COM | 35 |
| LFE2M35E-5F484C | 303 | 1.2V | -5 | fpBGA | 484 | COM | 35 |
| LFE2M35E-6F484C | 303 | 1.2V | -6 | fpBGA | 484 | COM | 35 |
| LFE2M35E-7F484C | 303 | 1.2V | -7 | fpBGA | 484 | COM | 35 |
| LFE2M35E-5F256C | 140 | 1.2V | -5 | fpBGA | 256 | COM | 35 |
| LFE2M35E-6F256C | 140 | 1.2V | -6 | fpBGA | 256 | COM | 35 |
| LFE2M35E-7F256C | 140 | 1.2V | -7 | fpBGA | 256 | COM | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2M50E-5F900C | 410 | 1.2V | -5 | fpBGA | 900 | COM | 50 |
| LFE2M50E-6F900C | 410 | 1.2V | -6 | fpBGA | 900 | COM | 50 |
| LFE2M50E-7F900C | 410 | 1.2V | -7 | fpBGA | 900 | COM | 50 |
| LFE2M50E-5F672C | 372 | 1.2V | -5 | fpBGA | 672 | COM | 50 |
| LFE2M50E-6F672C | 372 | 1.2V | -6 | fpBGA | 672 | COM | 50 |
| LFE2M50E-7F672C | 372 | 1.2V | -7 | fpBGA | 672 | COM | 50 |
| LFE2M50E-5F484C | 270 | 1.2V | -5 | fpBGA | 484 | COM | 50 |
| LFE2M50E-6F484C | 270 | 1.2V | -6 | fpBGA | 484 | COM | 50 |
| LFE2M50E-7F484C | 270 | 1.2V | -7 | fpBGA | 484 | COM | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M70E-5F1152C | 436 | 1.2V | -5 | fpBGA | 1152 | COM | 70 |
| LFE2M70E-6F1152C | 436 | 1.2V | -6 | fpBGA | 1152 | COM | 70 |
| LFE2M70E-7F1152C | 436 | 1.2V | -7 | fpBGA | 1152 | COM | 70 |
| LFE2M70E-5F900C | 416 | 1.2V | -5 | fpBGA | 900 | COM | 70 |
| LFE2M70E-6F900C | 416 | 1.2V | -6 | fpBGA | 900 | COM | 70 |
| LFE2M70E-7F900C | 416 | 1.2V | -7 | fpBGA | 900 | COM | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M100E-5F1152C | 520 | 1.2V | -5 | fpBGA | 1152 | COM | 100 |
| LFE2M100E-6F1152C | 520 | 1.2V | -6 | fpBGA | 1152 | COM | 100 |
| LFE2M100E-7F1152C | 520 | 1.2V | -7 | fpBGA | 1152 | COM | 100 |
| LFE2M100E-5F900C | 416 | 1.2V | -5 | fpBGA | 900 | COM | 100 |
| LFE2M100E-6F900C | 416 | 1.2V | -6 | fpBGA | 900 | COM | 100 |
| LFE2M100E-7F900C | 416 | 1.2V | -7 | fpBGA | 900 | COM | 100 |

Industrial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2M20E-5F484I | 304 | 1.2V | -5 | fpBGA | 484 | IND | 20 |
| LFE2M20E-6F484I | 304 | 1.2V | -6 | fpBGA | 484 | IND | 20 |
| LFE2M20E-5F256I | 140 | 1.2V | -5 | fpBGA | 256 | IND | 20 |
| LFE2M20E-6F256I | 140 | 1.2V | -6 | fpBGA | 256 | IND | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2M35E-5F672I | 410 | 1.2V | -5 | fpBGA | 672 | IND | 35 |
| LFE2M35E-6F672I | 410 | 1.2V | -6 | fpBGA | 672 | IND | 35 |
| LFE2M35E-5F484I | 303 | 1.2V | -5 | fpBGA | 484 | IND | 35 |
| LFE2M35E-6F484I | 303 | 1.2V | -6 | fpBGA | 484 | IND | 35 |
| LFE2M35E-5F256I | 140 | 1.2V | -5 | fpBGA | 256 | IND | 35 |
| LFE2M35E-6F256I | 140 | 1.2V | -6 | fpBGA | 256 | IND | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-----------------|------|---------|-------|---------|------|-------|----------|
| LFE2M50E-5F900I | 410 | 1.2V | -5 | fpBGA | 900 | IND | 50 |
| LFE2M50E-6F900I | 410 | 1.2V | -6 | fpBGA | 900 | IND | 50 |
| LFE2M50E-5F672I | 372 | 1.2V | -5 | fpBGA | 672 | IND | 50 |
| LFE2M50E-6F672I | 372 | 1.2V | -6 | fpBGA | 672 | IND | 50 |
| LFE2M50E-5F484I | 270 | 1.2V | -5 | fpBGA | 484 | IND | 50 |
| LFE2M50E-6F484I | 270 | 1.2V | -6 | fpBGA | 484 | IND | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M70E-5F1152I | 436 | 1.2V | -5 | fpBGA | 1152 | IND | 70 |
| LFE2M70E-6F1152I | 436 | 1.2V | -6 | fpBGA | 1152 | IND | 70 |
| LFE2M70E-5F900I | 416 | 1.2V | -5 | fpBGA | 900 | IND | 70 |
| LFE2M70E-6F900I | 416 | 1.2V | -6 | fpBGA | 900 | IND | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M100E-5F1152I | 520 | 1.2V | -5 | fpBGA | 1152 | IND | 100 |
| LFE2M100E-6F1152I | 520 | 1.2V | -6 | fpBGA | 1152 | IND | 100 |
| LFE2M100E-5F900I | 416 | 1.2V | -5 | fpBGA | 900 | IND | 100 |
| LFE2M100E-6F900I | 416 | 1.2V | -6 | fpBGA | 900 | IND | 100 |

LatticeECP2M Standard Series Devices, Lead-Free Packaging

Commercial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M20E-5FN484C | 304 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 20 |
| LFE2M20E-6FN484C | 304 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 20 |
| LFE2M20E-7FN484C | 304 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 20 |
| LFE2M20E-5FN256C | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | COM | 20 |
| LFE2M20E-6FN256C | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | COM | 20 |
| LFE2M20E-7FN256C | 140 | 1.2V | -7 | Lead-Free fpBGA | 256 | COM | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M35E-5FN672C | 410 | 1.2V | -5 | Lead-Free fpBGA | 672 | COM | 35 |
| LFE2M35E-6FN672C | 410 | 1.2V | -6 | Lead-Free fpBGA | 672 | COM | 35 |
| LFE2M35E-7FN672C | 410 | 1.2V | -7 | Lead-Free fpBGA | 672 | COM | 35 |
| LFE2M35E-5FN484C | 303 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 35 |
| LFE2M35E-6FN484C | 303 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 35 |
| LFE2M35E-7FN484C | 303 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 35 |
| LFE2M35E-5FN256C | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | COM | 35 |
| LFE2M35E-6FN256C | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | COM | 35 |
| LFE2M35E-7FN256C | 140 | 1.2V | -7 | Lead-Free fpBGA | 256 | COM | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M50E-5FN900C | 410 | 1.2V | -5 | Lead-Free fpBGA | 900 | COM | 50 |
| LFE2M50E-6FN900C | 410 | 1.2V | -6 | Lead-Free fpBGA | 900 | COM | 50 |
| LFE2M50E-7FN900C | 410 | 1.2V | -7 | Lead-Free fpBGA | 900 | COM | 50 |
| LFE2M50E-5FN672C | 372 | 1.2V | -5 | Lead-Free fpBGA | 672 | COM | 50 |
| LFE2M50E-6FN672C | 372 | 1.2V | -6 | Lead-Free fpBGA | 672 | COM | 50 |
| LFE2M50E-7FN672C | 372 | 1.2V | -7 | Lead-Free fpBGA | 672 | COM | 50 |
| LFE2M50E-5FN484C | 270 | 1.2V | -5 | Lead-Free fpBGA | 484 | COM | 50 |
| LFE2M50E-6FN484C | 270 | 1.2V | -6 | Lead-Free fpBGA | 484 | COM | 50 |
| LFE2M50E-7FN484C | 270 | 1.2V | -7 | Lead-Free fpBGA | 484 | COM | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M70E-5FN1152C | 436 | 1.2V | -5 | Lead-Free fpBGA | 1152 | COM | 70 |
| LFE2M70E-6FN1152C | 436 | 1.2V | -6 | Lead-Free fpBGA | 1152 | COM | 70 |
| LFE2M70E-7FN1152C | 436 | 1.2V | -7 | Lead-Free fpBGA | 1152 | COM | 70 |
| LFE2M70E-5FN900C | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | COM | 70 |
| LFE2M70E-6FN900C | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | COM | 70 |
| LFE2M70E-7FN900C | 416 | 1.2V | -7 | Lead-Free fpBGA | 900 | COM | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|--------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M100E-5FN1152C | 520 | 1.2V | -5 | Lead-Free fpBGA | 1152 | COM | 100 |
| LFE2M100E-6FN1152C | 520 | 1.2V | -6 | Lead-Free fpBGA | 1152 | COM | 100 |
| LFE2M100E-7FN1152C | 520 | 1.2V | -7 | Lead-Free fpBGA | 1152 | COM | 100 |
| LFE2M100E-5FN900C | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | COM | 100 |
| LFE2M100E-6FN900C | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | COM | 100 |
| LFE2M100E-7FN900C | 416 | 1.2V | -7 | Lead-Free fpBGA | 900 | COM | 100 |

Industrial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M20E-5FN484I | 304 | 1.2V | -5 | Lead-Free fpBGA | 484 | IND | 20 |
| LFE2M20E-6FN484I | 304 | 1.2V | -6 | Lead-Free fpBGA | 484 | IND | 20 |
| LFE2M20E-5FN256I | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | IND | 20 |
| LFE2M20E-6FN256I | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | IND | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M35E-5FN672I | 410 | 1.2V | -5 | Lead-Free fpBGA | 672 | IND | 35 |
| LFE2M35E-6FN672I | 410 | 1.2V | -6 | Lead-Free fpBGA | 672 | IND | 35 |
| LFE2M35E-5FN484I | 303 | 1.2V | -5 | Lead-Free fpBGA | 484 | IND | 35 |
| LFE2M35E-6FN484I | 303 | 1.2V | -6 | Lead-Free fpBGA | 484 | IND | 35 |
| LFE2M35E-5FN256I | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | IND | 35 |
| LFE2M35E-6FN256I | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | IND | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M50E-5FN900I | 410 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 50 |
| LFE2M50E-6FN900I | 410 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 50 |
| LFE2M50E-5FN672I | 372 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 50 |
| LFE2M50E-6FN672I | 372 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 50 |
| LFE2M50E-5FN484I | 270 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 50 |
| LFE2M50E-6FN484I | 270 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M70E-5FN1152I | 436 | 1.2V | -5 | Lead-Free fpBGA | 1152 | Ind | 70 |
| LFE2M70E-6FN1152I | 436 | 1.2V | -6 | Lead-Free fpBGA | 1152 | Ind | 70 |
| LFE2M70E-5FN900I | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 70 |
| LFE2M70E-6FN900I | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|--------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M100E-5FN1152I | 520 | 1.2V | -5 | Lead-Free fpBGA | 1152 | Ind | 100 |
| LFE2M100E-6FN1152I | 520 | 1.2V | -6 | Lead-Free fpBGA | 1152 | Ind | 100 |
| LFE2M100E-5FN900I | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 100 |
| LFE2M100E-6FN900I | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 100 |

LatticeECP2M S-Series Devices, Conventional Packaging

Commercial

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M20SE-5F484C | 304 | 1.2V | -5 | fpBGA | 484 | Com | 20 |
| LFE2M20SE-6F484C | 304 | 1.2V | -6 | fpBGA | 484 | Com | 20 |
| LFE2M20SE-7F484C | 304 | 1.2V | -7 | fpBGA | 484 | Com | 20 |
| LFE2M20SE-5F256C | 140 | 1.2V | -5 | fpBGA | 256 | Com | 20 |
| LFE2M20SE-6F256C | 140 | 1.2V | -6 | fpBGA | 256 | Com | 20 |
| LFE2M20SE-7F256C | 140 | 1.2V | -7 | fpBGA | 256 | Com | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M35SE-5F672C | 410 | 1.2V | -5 | fpBGA | 672 | Com | 35 |
| LFE2M35SE-6F672C | 410 | 1.2V | -6 | fpBGA | 672 | Com | 35 |
| LFE2M35SE-7F672C | 410 | 1.2V | -7 | fpBGA | 672 | Com | 35 |
| LFE2M35SE-5F484C | 303 | 1.2V | -5 | fpBGA | 484 | Com | 35 |
| LFE2M35SE-6F484C | 303 | 1.2V | -6 | fpBGA | 484 | Com | 35 |
| LFE2M35SE-7F484C | 303 | 1.2V | -7 | fpBGA | 484 | Com | 35 |
| LFE2M35SE-5F256C | 140 | 1.2V | -5 | fpBGA | 256 | Com | 35 |
| LFE2M35SE-6F256C | 140 | 1.2V | -6 | fpBGA | 256 | Com | 35 |
| LFE2M35SE-7F256C | 140 | 1.2V | -7 | fpBGA | 256 | Com | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M50SE-5F900C | 410 | 1.2V | -5 | fpBGA | 900 | Com | 50 |
| LFE2M50SE-6F900C | 410 | 1.2V | -6 | fpBGA | 900 | Com | 50 |
| LFE2M50SE-7F900C | 410 | 1.2V | -7 | fpBGA | 900 | Com | 50 |
| LFE2M50SE-5F672C | 372 | 1.2V | -5 | fpBGA | 672 | Com | 50 |
| LFE2M50SE-6F672C | 372 | 1.2V | -6 | fpBGA | 672 | Com | 50 |
| LFE2M50SE-7F672C | 372 | 1.2V | -7 | fpBGA | 672 | Com | 50 |
| LFE2M50SE-5F484C | 270 | 1.2V | -5 | fpBGA | 484 | Com | 50 |
| LFE2M50SE-6F484C | 270 | 1.2V | -6 | fpBGA | 484 | Com | 50 |
| LFE2M50SE-7F484C | 270 | 1.2V | -7 | fpBGA | 484 | Com | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M70SE-5F1152C | 436 | 1.2V | -5 | fpBGA | 1152 | Com | 70 |
| LFE2M70SE-6F1152C | 436 | 1.2V | -6 | fpBGA | 1152 | Com | 70 |
| LFE2M70SE-7F1152C | 436 | 1.2V | -7 | fpBGA | 1152 | Com | 70 |
| LFE2M70SE-5F900C | 416 | 1.2V | -5 | fpBGA | 900 | Com | 70 |
| LFE2M70SE-6F900C | 416 | 1.2V | -6 | fpBGA | 900 | Com | 70 |
| LFE2M70SE-7F900C | 416 | 1.2V | -7 | fpBGA | 900 | Com | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|--------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M100SE-5F1152C | 520 | 1.2V | -5 | fpBGA | 1152 | Com | 100 |
| LFE2M100SE-6F1152C | 520 | 1.2V | -6 | fpBGA | 1152 | Com | 100 |
| LFE2M100SE-7F1152C | 520 | 1.2V | -7 | fpBGA | 1152 | Com | 100 |
| LFE2M100SE-5F900C | 416 | 1.2V | -5 | fpBGA | 900 | Com | 100 |
| LFE2M100SE-6F900C | 416 | 1.2V | -6 | fpBGA | 900 | Com | 100 |
| LFE2M100SE-7F900C | 416 | 1.2V | -7 | fpBGA | 900 | Com | 100 |

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| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M20SE-5F484I | 304 | 1.2V | -5 | fpBGA | 484 | Ind | 20 |
| LFE2M20SE-6F484I | 304 | 1.2V | -6 | fpBGA | 484 | Ind | 20 |
| LFE2M20SE-5F256I | 140 | 1.2V | -5 | fpBGA | 256 | Ind | 20 |
| LFE2M20SE-6F256I | 140 | 1.2V | -6 | fpBGA | 256 | Ind | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M35SE-5F672I | 410 | 1.2V | -5 | fpBGA | 672 | Ind | 35 |
| LFE2M35SE-6F672I | 410 | 1.2V | -6 | fpBGA | 672 | Ind | 35 |
| LFE2M35SE-5F484I | 303 | 1.2V | -5 | fpBGA | 484 | Ind | 35 |
| LFE2M35SE-6F484I | 303 | 1.2V | -6 | fpBGA | 484 | Ind | 35 |
| LFE2M35SE-5F256I | 140 | 1.2V | -5 | fpBGA | 256 | Ind | 35 |
| LFE2M35SE-6F256I | 140 | 1.2V | -6 | fpBGA | 256 | Ind | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M50SE-5F900I | 410 | 1.2V | -5 | fpBGA | 900 | Ind | 50 |
| LFE2M50SE-6F900I | 410 | 1.2V | -6 | fpBGA | 900 | Ind | 50 |
| LFE2M50SE-5F672I | 372 | 1.2V | -5 | fpBGA | 672 | Ind | 50 |
| LFE2M50SE-6F672I | 372 | 1.2V | -6 | fpBGA | 672 | Ind | 50 |
| LFE2M50SE-5F484I | 270 | 1.2V | -5 | fpBGA | 484 | Ind | 50 |
| LFE2M50SE-6F484I | 270 | 1.2V | -6 | fpBGA | 484 | Ind | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M70SE-5F1152I | 436 | 1.2V | -5 | fpBGA | 1152 | Ind | 70 |
| LFE2M70SE-6F1152I | 436 | 1.2V | -6 | fpBGA | 1152 | Ind | 70 |
| LFE2M70SE-5F900I | 416 | 1.2V | -5 | fpBGA | 900 | Ind | 70 |
| LFE2M70SE-6F900I | 416 | 1.2V | -6 | fpBGA | 900 | Ind | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|--------------------|------|---------|-------|---------|------|-------|----------|
| LFE2M100SE-5F1152I | 520 | 1.2V | -5 | fpBGA | 1152 | Ind | 100 |
| LFE2M100SE-6F1152I | 520 | 1.2V | -6 | fpBGA | 1152 | Ind | 100 |
| LFE2M100SE-5F900I | 416 | 1.2V | -5 | fpBGA | 900 | Ind | 100 |
| LFE2M100SE-6F900I | 416 | 1.2V | -6 | fpBGA | 900 | Ind | 100 |

LatticeECP2M S-Series Devices, Lead-Free Packaging**Commercial**

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M20SE-5FN484C | 304 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 20 |
| LFE2M20SE-6FN484C | 304 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 20 |
| LFE2M20SE-7FN484C | 304 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 20 |
| LFE2M20SE-5FN256C | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | Com | 20 |
| LFE2M20SE-6FN256C | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | Com | 20 |
| LFE2M20SE-7FN256C | 140 | 1.2V | -7 | Lead-Free fpBGA | 256 | Com | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M35SE-5FN672C | 410 | 1.2V | -5 | Lead-Free fpBGA | 672 | Com | 35 |
| LFE2M35SE-6FN672C | 410 | 1.2V | -6 | Lead-Free fpBGA | 672 | Com | 35 |
| LFE2M35SE-7FN672C | 410 | 1.2V | -7 | Lead-Free fpBGA | 672 | Com | 35 |
| LFE2M35SE-5FN484C | 303 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 35 |
| LFE2M35SE-6FN484C | 303 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 35 |
| LFE2M35SE-7FN484C | 303 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 35 |
| LFE2M35SE-5FN256C | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | Com | 35 |
| LFE2M35SE-6FN256C | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | Com | 35 |
| LFE2M35SE-7FN256C | 140 | 1.2V | -7 | Lead-Free fpBGA | 256 | Com | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M50SE-5FN900C | 410 | 1.2V | -5 | Lead-Free fpBGA | 900 | Com | 50 |
| LFE2M50SE-6FN900C | 410 | 1.2V | -6 | Lead-Free fpBGA | 900 | Com | 50 |
| LFE2M50SE-7FN900C | 410 | 1.2V | -7 | Lead-Free fpBGA | 900 | Com | 50 |
| LFE2M50SE-5FN672C | 372 | 1.2V | -5 | Lead-Free fpBGA | 672 | Com | 50 |
| LFE2M50SE-6FN672C | 372 | 1.2V | -6 | Lead-Free fpBGA | 672 | Com | 50 |
| LFE2M50SE-7FN672C | 372 | 1.2V | -7 | Lead-Free fpBGA | 672 | Com | 50 |
| LFE2M50SE-5FN484C | 270 | 1.2V | -5 | Lead-Free fpBGA | 484 | Com | 50 |
| LFE2M50SE-6FN484C | 270 | 1.2V | -6 | Lead-Free fpBGA | 484 | Com | 50 |
| LFE2M50SE-7FN484C | 270 | 1.2V | -7 | Lead-Free fpBGA | 484 | Com | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|--------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M70SE-5FN1152C | 436 | 1.2V | -5 | Lead-Free fpBGA | 1152 | Com | 70 |
| LFE2M70SE-6FN1152C | 436 | 1.2V | -6 | Lead-Free fpBGA | 1152 | Com | 70 |
| LFE2M70SE-7FN1152C | 436 | 1.2V | -7 | Lead-Free fpBGA | 1152 | Com | 70 |
| LFE2M70SE-5FN900C | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | Com | 70 |
| LFE2M70SE-6FN900C | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | Com | 70 |
| LFE2M70SE-7FN900C | 416 | 1.2V | -7 | Lead-Free fpBGA | 900 | Com | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|---------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M100SE-5FN1152C | 520 | 1.2V | -5 | Lead-Free fpBGA | 1152 | Com | 100 |
| LFE2M100SE-6FN1152C | 520 | 1.2V | -6 | Lead-Free fpBGA | 1152 | Com | 100 |
| LFE2M100SE-7FN1152C | 520 | 1.2V | -7 | Lead-Free fpBGA | 1152 | Com | 100 |
| LFE2M100SE-5FN900C | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | Com | 100 |
| LFE2M100SE-6FN900C | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | Com | 100 |
| LFE2M100SE-7FN900C | 416 | 1.2V | -7 | Lead-Free fpBGA | 900 | Com | 100 |

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| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M20SE-5FN484I | 304 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 20 |
| LFE2M20SE-6FN484I | 304 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 20 |
| LFE2M20SE-5FN256I | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | Ind | 20 |
| LFE2M20SE-6FN256I | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | Ind | 20 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M35SE-5FN672I | 410 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 35 |
| LFE2M35SE-6FN672I | 410 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 35 |
| LFE2M35SE-5FN484I | 303 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 35 |
| LFE2M35SE-6FN484I | 303 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 35 |
| LFE2M35SE-5FN256I | 140 | 1.2V | -5 | Lead-Free fpBGA | 256 | Ind | 35 |
| LFE2M35SE-6FN256I | 140 | 1.2V | -6 | Lead-Free fpBGA | 256 | Ind | 35 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|-------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M50SE-5FN900I | 410 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 50 |
| LFE2M50SE-6FN900I | 410 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 50 |
| LFE2M50SE-5FN672I | 372 | 1.2V | -5 | Lead-Free fpBGA | 672 | Ind | 50 |
| LFE2M50SE-6FN672I | 372 | 1.2V | -6 | Lead-Free fpBGA | 672 | Ind | 50 |
| LFE2M50SE-5FN484I | 270 | 1.2V | -5 | Lead-Free fpBGA | 484 | Ind | 50 |
| LFE2M50SE-6FN484I | 270 | 1.2V | -6 | Lead-Free fpBGA | 484 | Ind | 50 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|--------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M70SE-5FN1152I | 436 | 1.2V | -5 | Lead-Free fpBGA | 1152 | Ind | 70 |
| LFE2M70SE-6FN1152I | 436 | 1.2V | -6 | Lead-Free fpBGA | 1152 | Ind | 70 |
| LFE2M70SE-5FN900I | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 70 |
| LFE2M70SE-6FN900I | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 70 |

| Part Number | I/Os | Voltage | Grade | Package | Pins | Temp. | LUTs (K) |
|---------------------|------|---------|-------|-----------------|------|-------|----------|
| LFE2M100SE-5FN1152I | 520 | 1.2V | -5 | Lead-Free fpBGA | 1152 | Ind | 100 |
| LFE2M100SE-6FN1152I | 520 | 1.2V | -6 | Lead-Free fpBGA | 1152 | Ind | 100 |
| LFE2M100SE-5FN900I | 416 | 1.2V | -5 | Lead-Free fpBGA | 900 | Ind | 100 |
| LFE2M100SE-6FN900I | 416 | 1.2V | -6 | Lead-Free fpBGA | 900 | Ind | 100 |

For Further Information

A variety of technical notes for the LatticeECP2/M family are available on the Lattice web site at www.latticesemi.com.

- TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#)
- TN1102, [LatticeECP2/M sysIO Usage Guide](#)
- TN1103, [LatticeECP2/M sysCLOCK PLL Design and Usage Guide](#)
- TN1104, [LatticeECP2/M Memory Usage Guide](#)
- TN1105, [LatticeECP2/M High-Speed I/O Interface](#)
- TN1106, [Power Estimation and Management for LatticeECP2/M Devices](#)
- TN1107, [LatticeECP2/M sysDSP Usage Guide](#)
- TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#)
- TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#)
- TN1113, [LatticeECP2/M Soft Error Detection \(SED\) Usage Guide](#)
- TN1162, [LatticeECP2/M Hardware Checklist](#)

For further information about interface standards refer to the following web sites:

- JEDEC Standards (LVTTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- PCI: www.pcisig.com

| Date | Version | Section | Change Summary |
|---|---------|---|--|
| February 2006 | 01.0 | — | Initial release. |
| August 2006 | 01.1 | Introduction | Updated Table 1-1 “LatticeECP2 Family Selection Guide”. |
| | | | Architecture |
| | | Updated Figure 2-13 “Secondary Clock Regions ECP2-50”. | |
| | | Updated Figure 2-25 “PIC Diagram”. | |
| | | Updated Figure 2-26 “Input Register Block for Left, Right and Bottom Edges”. | |
| | | Updated Figure 2-28 “Output Register Block for Left, Right and Bottom Edges”. | |
| | | Updated Figure 2-30 “DQS Input Routing for Left and Right Edges”. | |
| | | Updated Figure 2-32 “Edge Clock, DLL Calibration and DQS Local Bus Distribution”. | |
| | | Table 2-15 Selectable Master Clock (CCLK) Frequencies - Removed frequencies 15, 20, 21, 22, 23, 30, 34, 41, 45, 51, 55, 60. | |
| | | Replaced “CLKINDEL” with “CLKO”. | |
| | | Updated SED section. | |
| | | Qualified device migration capability when using DQS banks for DDR interfaces. | |
| | | DC and Switching Characteristics | Added VCCPLL to the Recommended Operating Conditions table. |
| | | | Removed note 5 from “Hot Specifications” section. |
| | | | Added notes 7 and 8 to “Initialization Supply” Current table. |
| | | | Change note 6 - “...down to 95MHz” to “...down to 95MHz for DDR and 133MHz for DDR2” . |
| | | | New “Typical Building Block Function Performance” numbers. |
| | | | New External Switching Characteristics numbers. |
| | | | New Internal Switching Characteristics numbers. |
| | | | New Family Timing Adders numbers. |
| | | | Updated Timings for GPLLs, SPLs and DLLs. |
| | | | Added sysCONFIG waveforms. |
| | | Remove HSTL15D_II from sysIO Recommended Operating Conditions table. | |
| | | Updated Supply and Initialization Currents for ECP2-50. | |
| | | Pinout Information | Added VCCPLL to the Signal Descriptions table. |
| | | | Updated Logic Signal Connections tables to include 484-fpBGA for the ECP2-50. |
| | | | Added Logic Signal Connections tables for ECP2-12 devices. |
| Updated Pin Information Summary table to include ECP2-12. | | | |
| Updated Power Supply and NC Connections table to include ECP2-12. | | | |
| Added note 2 to DDR Strobe (DQS) Pin table. | | | |
| Added Information on: PCI, DDR & SPI4.2 Capabilities of the device-Package combination. | | | |

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| Date | Version | Section | Change Summary |
|--|--|-------------------------------------|--|
| August 2006 (cont.) | 01.1 (cont.) | Pinout Information (cont.) | Added Information on: Available Device Resources per Packaged Device table. |
| | | Ordering Information | Updated ordering part number table to include ECP2-12. Updated topside mark drawing. |
| September 2006 | 02.0 | Multiple | Added information regarding LatticeECP2M support throughout. |
| September 2006 | 02.1 | DC and Switching Characteristics | Added Receiver Total Jitter Tolerance Specification table. |
| | | | Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table. |
| December 2006 | 02.2 | Introduction | LatticeECP2M Selection Guide table has been updated. |
| | | Architecture | Figure 2-16. Per Region Secondary Clock Selection has been updated. |
| | | | Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated. |
| | | DC and Switching | Footnotes have been added to Recommended Operating Conditions. |
| | | | DC Electrical Characteristics table has been updated. |
| | | | Supply Current (Standby) tables have been updated. |
| Initialization Supply Current table have been updated. | | | |
| Updated timing numbers to include LFE2-12E (rev A 0.08). | | | |
| Pinout Information | Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E. | | |
| Ordering Information | Updated to include the entire ECP2 and ECP2M device ordering information. | | |
| February 2007 | 02.3 | Architecture | Updated EBR Asynchronous Reset section. |
| March 2007 | 02.4 | DC and Switching Characteristics | Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz. |
| March 2007 | 02.5 | Introduction | Added "Security Series" to the LatticeECP2 and LatticeECP2M families. |
| | | Architecture | Enhanced Configuration Option section updated. |
| | | DC and Switching | Recommended Operating Conditions table - footnote 4 updated. |
| | | Ordering Information | "Security Series" ordering part numbers added. |
| April 2007 | 02.6 | Introduction | LatticeECP2M family table has been updated for user I/O counts. |
| | | Ordering Information | LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100. |
| July 2007 | 02.7 | Architecture | Updated text in Ripple Mode section. |
| | | DC and Switching | ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated. |
| | | Pinout Information | Added LatticeECP2M20 pinout information. |
| August 2007 | 02.8 | Introduction | 1156-fpBGA package option has been removed from the LatticeECP2M family. |
| | | Architecture | Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated. |
| | | DC and Switching | Supply Current (Standby) table has been updated. |
| DSP Function timing has been updated. | | | |

| Date | Version | Section | Change Summary |
|----------------------------------|--|----------------------------------|--|
| August 2007 (cont.) | 02.8 (cont.) | DC and Switching (cont.) | sysCLOCK GPLL timing has been updated. |
| | | Pinout Information | Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information. |
| | | Ordering Information | 1156-fpBGA package option has been removed from the LatticeECP2M family. |
| September 2007 | 02.9 | Pinout Information | Added Thermal Management text section. |
| February 2008 | 03.0 | Architecture | Added LVC MOS33D description. |
| | | DC and Switching | LatticeECP2M Supply Current has been updated. |
| | | | Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11). |
| | | | Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated. |
| | | | Table 3-8. Channel output Jitter (Max) has been updated. |
| Pinout Information | Signal description has been updated. Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100. | | |
| April 2008 | 03.1 | Pinout Information | Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated. |
| June 2008 | 03.2 | Introduction | Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device. |
| | | Architecture | Removed Read-Before-Write sysMEM EBR mode. |
| | | | Clarification of the operation of the secondary clock regions. |
| DC and Switching Characteristics | Removed Read-Before-Write sysMEM EBR mode. | | |
| August 2008 | 03.3 | Architecture | Clarification of the operation of the secondary clock regions. |
| | | Pinout Information | Added information for [LOC]DQ[num] to Signal Descriptions table. |
| January 2009 | 03.4 | DC and Switching Characteristics | Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode. |
| | | | Added Channel Output Jitter table for x20 mode. |
| November 2009 | 03.5 | DC and Switching Characteristics | Updated SPI/SPI _m Configuration Waveforms diagram. |
| | | | Updated footnotes in LatticeECP2 Initialization Supply Current table. |
| | | | Updated footnotes in LatticeECP2M Initialization Supply Current table. |
| | | | Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table. |
| | | | Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table. |
| | | | Updated Serial Output Timing and Levels table. |
| | | | Updated Figure 3-5 MLVDS |
| | | | Updated Table 3-7 Serial Output Timing and Levels |
| | | | Updated Table 3-15 Power Down/Power Up Specification |
| | | Pinout Information | Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5. |

| Date | Version | Section | Change Summary |
|--------------------------|-------------------------|---|--|
| November 2009 (cont.) | 03.5 (cont.) | Pinout Information (cont.) | LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 table - corrected values for LFE2M50, 672 fpBGA in Available DDR-Interfaces per I/O Bank. |
| | | | Minor corrections in LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA table. |
| | | | Minor corrections in LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA table. |
| | | | Minor corrections in LFE2M100E/SE Logic Signal Connections: 900 fpBGA table. |
| | | Updated LFE2-6E/SE and LFE2-12E/SE Logical Signal Connections (changed D1/SPIDS to D1). | |
| | | Ordering Information | Updated LatticeECP2M Part Number Description diagram. |
| March 2010 | 03.6 | DC and Switching Characteristics | Footnote for SED operating frequency added to the sysCONFIG Port Timing Specifications table. |
| | | Pinout Information | Changed Dual Function pin E7 to be D7/SPDI0 in Logic Signal Connections tables. Changed footnote (***) in Logic Signal Connections table. |
| July 2010 | 03.7 | Architecture | Updated the Typical sysIO Behavior During Power-up text section. |
| | | Pinout Information | Added reference to powerup information. |
| | | | Corrected reference to footnote for pins 131 and 132 for the LFE-20E/SE, 208 PQFP. |
| | | | Referenced footnote (***) for all D7/SPID0. |
| | | | Changed D7*** to D7/SPID0. |
| All Sections | Corrected *** footnote. | | |
| | | All Sections | Included references to Lattice Diamond design software wherever ispLEVER and ispLeverCORE is specified. |
| April 2011 | 03.8 | DC and Switching Characteristics | DC Electrical Characteristics table: - Added footnote 3 to I_{IH} - Added footnote 2 to I_{IL} , I_{IH} - Updated C1 and C2 typ. and max. data. |
| | | | DLL Timing table – Removed line for t_R and t_F |
| | | | LatticeECP2/M sysCONFIG Port Timing Specifications table – added footnote to t_{DINIT} . |
| | | Figure 3-18 – Corrected label to be PRGM (not PRGMRJ). | |
| | | Pinout Information | LFE2-12E/SE and LFE-20/SE Logical Signal Connections for 208 PQFP – Corrected Dual Function information for pins 112, 114, 117, 119. |
| January 2012 | 03.9 | Multiple | Removed references to ispLEVER design software. |
| | | Architecture | Corrected information regarding SED support. |
| | | DC and Switching Characteristics | Added reference to ESD information. |



Section II. LatticeECP2/M Family Technical Notes

Introduction to PCS

The LatticeECP2M™ FPGA family combines a high-performance FPGA fabric, high-performance I/Os and large embedded RAM in a single industry-leading architecture. All LatticeECP2M devices also feature up to 16 channels of embedded SERDES with associated Physical Coding Sublayer (PCS) logic. The PCS logic can be configured to support numerous industry-standard, high-speed data transfer protocols.

Each channel of PCS logic contains dedicated transmit and receive SERDES for high-speed full-duplex serial data transfers at data rates up to 3.125 Gbps. The PCS logic in each channel can be configured to support an array of popular data protocols including Ethernet (1GbE and SGMII), PCI Express, CPRI, and OBSAI. In addition, the protocol-based logic can be fully or partially bypassed in a number of configurations to allow users flexibility in designing their own high-speed data interface.

The PCS also provides bypass modes that allow for a direct 8-bit or 10-bit interface from the SERDES to the FPGA logic. Each SERDES pin can be independently DC-coupled and can allow for both high-speed and low-speed operation on the same SERDES pin for such applications as Serial Digital Video.

Features

- Up to 16 Channels of High-Speed SERDES
 - 250 Mbps to 3.125 Gbps per channel
 - 3.125Gbps operation with low 100mW power per channel
 - Receive equalization and transmit pre-emphasis for small form factor backplane operation
 - Supports PCI Express, Ethernet (1GbE and SGMII) plus multiple other standards
 - Supports user specified generic 8b10b mode
 - Beacon support for PCI Express
 - Out-of-band signal interface for low speed inputs (video application)
- Multiple Clock Rate Support
 - Separate reference clocks for each PCS quad allow easy handling of multiple protocol rates on a single device
- Full Function Embedded Physical Coding Sub-layer (PCS) Logic Supporting Industry Standard Protocols
 - Up to 16 channels of full-duplex data supported per device
 - Multiple protocol support on one chip
 - Supports popular 8b10b based packet protocols
 - SERDES Only mode allows direct 8- or 10-bit interface to FPGA logic
- Gigabit Ethernet Support
 - IEEE 1000BASE-X compliant
 - 8b10b encoding/decoding
 - Insertion of /12/ symbols into the receive data stream for auto-negotiation support
 - Comma character word alignment
 - Clock Tolerance Compensation circuit
- PCI Express Support
 - x1 to x4 support in one PCS quad
 - Integrated Word aligner
 - 8b10b encoding/decoding
 - Clock Tolerance Compensation circuit
 - Electrical Idle and Receiver Detection support
 - Support for Beacon Transmission and Beacon Detection

- Multiple Protocol Compliant Clock Tolerance Compensation (CTC) Logic
 - Compensates for frequency differential between reference clock and received data rate
 - Allows user defined Skip pattern of 1, 2, or 4 bytes in length
- Integrated Loopback Modes for System Debugging
 - Three loopback modes are provided for system debugging

Supported Standards

The supported standards are listed in Table 8-1.

Table 8-1. Supported SERDES Standards (Fully Supported)

| Standard | Rates (Mbps) | REFCLK (MHz) | FPGA CLK (MHz) | Encoding | Signal Type |
|---------------------------------|--------------------|--------------------|--------------------|-----------------|-------------|
| PCI Express | 2500 | 100 | 250 | 8b10b | CML |
| GbE/SGMII | 1250 | 125 | 125 | 8b10b | CML |
| Generic 8b10b | 250 to 3125 | 25 to 312.5 | 25 to 312.5 | 8b10b/None | CML |
| 10-bit SERDES Only ¹ | 250 to 3125 | 25 to 312.5 | 25 to 312.5 | None | CML |
| 8-bit SERDES Only ¹ | 250 to 3125 | 25 to 312.5 | 25 to 312.5 | None | CML |
| SD-SDI ² | 143, 177, 270, 360 | 14.3, 17.7, 27, 36 | 143, 177, 135, 180 | SMPTE scrambled | CML |
| HD-SDI | 1483.5, 1485 | 148.35, 148.5 | 148.35, 148.5 | SMPTE scrambled | CML |
| CPRI | 614.4 1228.8 | 61.44 122.88 | 61.44 122.88 | 8b10b | CML |

1. 8-bit SERDES Only Mode and 10-bit SERDES Only Mode bypass the Link Align/Comma Align, 8b10b encoder/decoder and the CTC. It does not bypass the CDR.
2. Serial Digital Interface (SDI) for Standard Definition (SD): 143Mbps, 177Mbps bypasses the SERDES/PCS Block. The clock and data come in to the FPGA through the RX pins but get into the FPGA core via the BSCAN path. CDR is done in the FPGA core. In the transmit direction, decimation is used for these “low” bit rates. To do the CDR in the FPGA, reference clock of 14.3MHz and 17.7MHz are required respectively. 270Mbps is the most common frequency. This will go through the 10-bit data path.

It is possible to support XAUI, SRIIO, OBSAI, CPRI, 1XFC, 2XFC, PICMG 3.1, PICMG 3.4, PICMG 3.5 and 3G-SDI standards with the SERDES modes specified above. Contact Lattice Semiconductor Technical Support Group for additional information.

Architecture Overview

The PCS logic is arranged in quads containing logic for four independent full-duplex data channels. Table 8-2 shows the availability of SERDES/PCS quads for each device in the LatticeECP2M family.

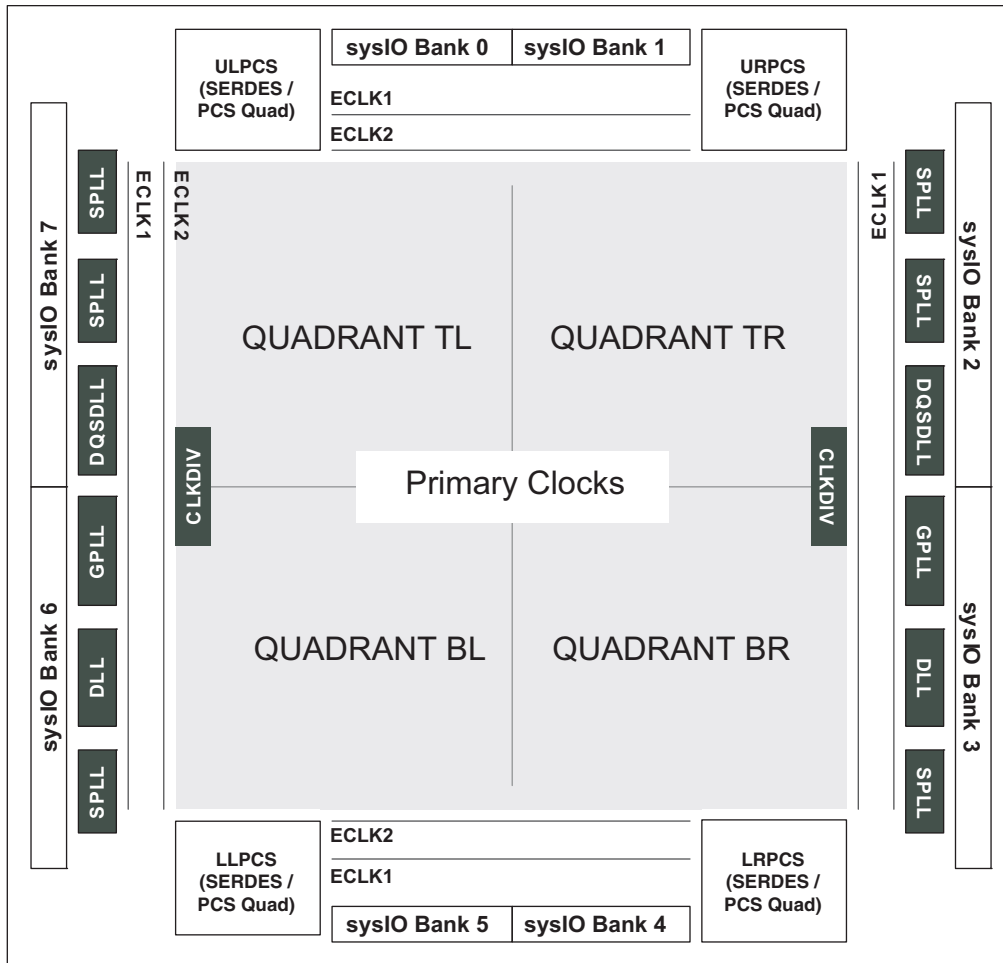
Table 8-2. SERDES/PCS Quads per LatticeECP2M Device

| Device | ECP2M20 | ECP2M35 | ECP2M50 | ECP2M70 | ECP2M100 |
|----------|---------|---------|---------|---------|----------|
| Quad URC | Yes | Yes | Yes | Yes | Yes |
| Quad LRC | — | — | Yes | Yes | Yes |
| Quad ULC | — | — | — | Yes | Yes |
| Quad LLC | — | — | — | Yes | Yes |

PCS Quad

Figure 8-1 is a layout of a LatticeECP2M device showing the arrangement of PCS quads on the device (the largest array containing 4 quads is shown. Other devices have fewer quads).

Figure 8-1. LatticeECP2M70/100 Block Diagram



Every quad can be programmed into one of several protocol based modes. Each quad requires its own reference clock which can be sourced externally from package pins or internally from the FPGA logic.

Since each quad has its own reference clock, different quads can support different standards on the same chip. This feature makes the LatticeECP2M family of devices ideal for bridging between different standards.

PCS quads are not dedicated solely to industry standard protocols. Each quad (and each channel within a quad) can be programmed for many user defined data manipulation modes. For example, modes governing user-defined word alignment, and clock tolerance compensation can be programmed for non-protocol operation.

PCS Quad and Channels

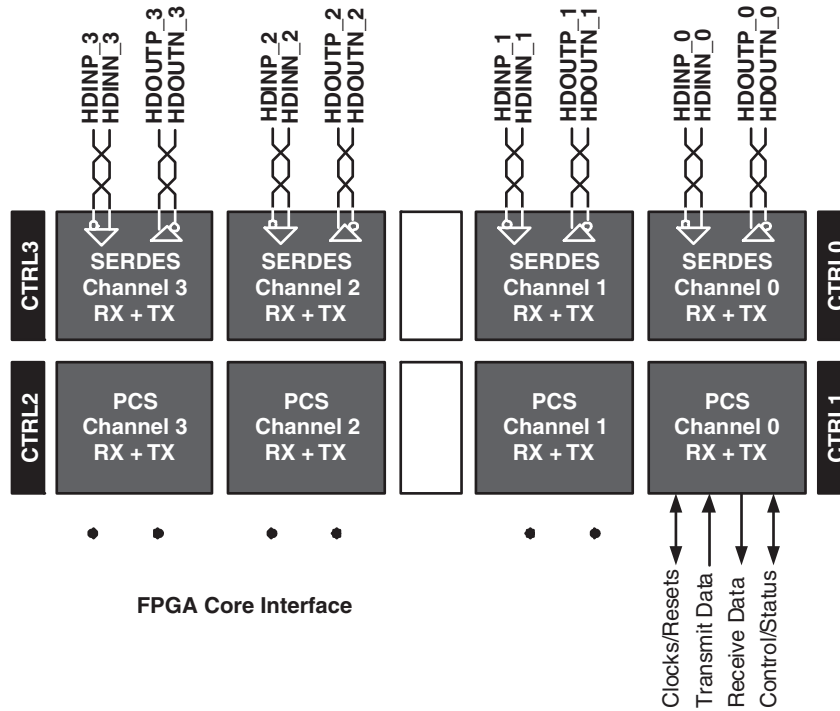
Each quad on a device supports up to four channels of full-duplex data. The user can utilize anywhere from one to four channels in a quad depending on the application. Many options can be set by the user for each channel independently within a given quad.

Figure 8-1 also shows an example of a device with four PCS quads which contain a total of 16 PCS channels. Quads are named according to the location of the respective quad on the LatticeECP2M array: URPCS (Upper Right PCS), ULPCS (Upper Left PCS), LRPCS (Lower Right PCS), LLPCS (Lower Left PCS).

Per Channel PCS/FPGA Interface Ports

All PCS quads regardless of chosen mode have the same external high speed serial interface at the package pins. However, every PCS mode has its own unique list of input/output ports from/to the FPGA logic appropriate to the protocol chosen for the quad. A detailed description of the quad input/output signals for each mode is provided in this document. A simplified diagram showing the channels within a single quad is shown in Figure 8-2.

Figure 8-2. PCS Quad Block Diagram



Locating a PCS Quad

LatticeECP2M-50 and larger devices include two to four PCS Quads.

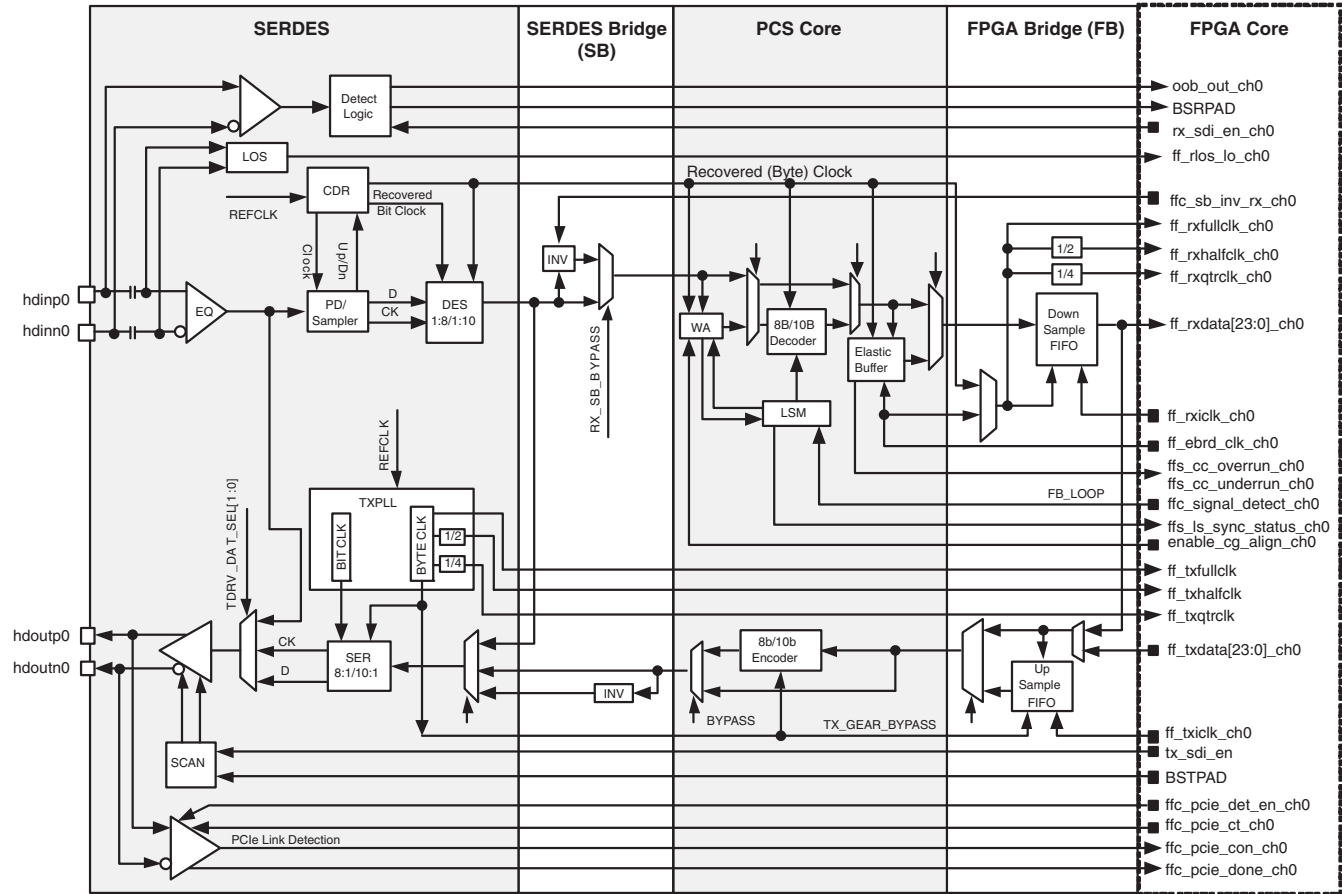
Users can locate each PCS Quad in a desired location using the LOCATE preference in the preference file. Below is an example of the preference, LOCATE.

```
LOCATE COMP "PCS_instantiation_1" SITE URPCS ;
```

Detailed Channel Block Diagram

Figure 8-3 is a detailed block diagram representation of the major functionality in a single channel of the LatticeECP2M SERDES/PCS. This diagram shows all the major blocks and the majority of the control and status signals that are visible to the user logic in the FPGA. This diagram also shows the major sub-blocks in the channel- SERDES, SERDES Bridge, PCS Core and the FPGA Bridge.

Figure 8-3. LatticeECP2M SERDES/PCS Detailed Channel Block Diagram



A general description of the FPGA interface signals follows.

Clocks and Resets

A PCS quad supplies per channel locked reference clocks and per channel recovered receive clocks to the FPGA logic interface. Each PCS quad provides these clocks on both primary and secondary FPGA clock routing. The PCS/FPGA interface also has ports for the transmit and receive clocks supplied from the FPGA fabric for all four channels in each quad.

Each quad has reset inputs to force reset of both the SERDES and PCS logic in a quad or just the SERDES. In addition, separate resets dedicated for the PCS logic are provided for each channel for both the transmit and receive directions.

Transmit Data Bus

The signals for the transmit data path are from the FPGA to the FPGA Bridge in the PCS Block. For high-speed standards, the datapath can be geared 2:1 to the internal PCS data path, which is 8 bits wide (+ control/status signals). The highest speed of the interface for PCI Express x1 is 250MHz in non-geared mode. With gearing (i.e. a 16-bit wide data path), the maximum speed is 156.25MHz (for XAUI 4x channel mode). The SERDES and PCS will support data rates up to 3.125Gbps data that correspond to an interface speed of 156.25MHz (with 2:1 gearing).

Receive Data Bus

The signals for the receive path are from the FPGA Bridge in the PCS Block to the FPGA. The data path may be geared 2:1 to the internal PCS data path which is 8 bits wide. It is possible to disable the gearing via a software register bit, in which case, the bus widths are halved. When the data is geared, the lower bits (ff_rx_d[9:0]) are the octet that has been received first and the higher bits (ff_rx_d[19:10]) are the octet that has been received second. If the data is not geared, the lower bits ((ff_rx_d[9:0]) are the active bits and the higher bits should not be used.

Table 8-3. Data Bus Usage by Mode

| Data Bus PCS Cell Name ⁵ | G8B10B | CPRI | PCI Express | GIGE | 8BSER | 10BSER | SDI |
|-------------------------------------|-------------------------------------|---------------------|----------------------------------|-------------------------------|------------------|-------------------|-----|
| FF_TX_D_0_0 | ff_txdata_ch0[0] | | | | | | |
| FF_TX_D_0_1 | ff_txdata_ch0[1] | | | | | | |
| FF_TX_D_0_2 | ff_txdata_ch0[2] | | | | | | |
| FF_TX_D_0_3 | ff_txdata_ch0[3] | | | | | | |
| FF_TX_D_0_4 | ff_txdata_ch0[4] | | | | | | |
| FF_TX_D_0_5 | ff_txdata_ch0[5] | | | | | | |
| FF_TX_D_0_6 | ff_txdata_ch0[6] | | | | | | |
| FF_TX_D_0_7 | ff_txdata_ch0[7] | | | | | | |
| FF_TX_D_0_8 | ff_tx_k_cntrl_ch0[0] | | | | GND | ff_txdata_ch0[8] | |
| FF_TX_D_0_9 | ff_force_disp_ch0[0]] ¹ | | | GND | | ff_txdata_ch0[9] | |
| FF_TX_D_0_10 | ff_disp_sel_ch0[0]] ¹ | | | ff_xmit_ch0[0]] ² | | GND | |
| FF_TX_D_0_11 | GND | ff_pci_ei_en_ch0[0] | | ff_correct_disp_ch0[0] | | GND | |
| FF_TX_D_0_12 | ff_txdata_ch0[8] | | | | | ff_txdata_ch0[10] | |
| FF_TX_D_0_13 | ff_txdata_ch0[9] | | | | | ff_txdata_ch0[11] | |
| FF_TX_D_0_14 | ff_txdata_ch0[10] | | | | | ff_txdata_ch0[12] | |
| FF_TX_D_0_15 | ff_txdata_ch0[11] | | | | | ff_txdata_ch0[13] | |
| FF_TX_D_0_16 | ff_txdata_ch0[12] | | | | | ff_txdata_ch0[14] | |
| FF_TX_D_0_17 | ff_txdata_ch0[13] | | | | | ff_txdata_ch0[15] | |
| FF_TX_D_0_18 | ff_txdata_ch0[14] | | | | | ff_txdata_ch0[16] | |
| FF_TX_D_0_19 | ff_txdata_ch0[15] | | | | | ff_txdata_ch0[17] | |
| FF_TX_D_0_20 | ff_tx_k_cntrl_ch0[1] | | | | GND | ff_txdata_ch0[18] | |
| FF_TX_D_0_21 | ff_force_disp_ch0[1]] ¹ | | | GND | | ff_txdata_ch0[19] | |
| FF_TX_D_0_22 | ff_disp_sel_ch0[1]] ¹ | | | ff_xmit_ch0[1]] ² | | GND | |
| FF_TX_D_0_23 | GND | ff_pci_ei_en_ch0[1] | | ff_correct_disp_ch0[1] | | GND | |
| FF_RX_D_0_0 | ff_rxdata_ch0[0] | | | | | | |
| FF_RX_D_0_1 | ff_rxdata_ch0[1] | | | | | | |
| FF_RX_D_0_2 | ff_rxdata_ch0[2] | | | | | | |
| FF_RX_D_0_3 | ff_rxdata_ch0[3] | | | | | | |
| FF_RX_D_0_4 | ff_rxdata_ch0[4] | | | | | | |
| FF_RX_D_0_5 | ff_rxdata_ch0[5] | | | | | | |
| FF_RX_D_0_6 | ff_rxdata_ch0[6] | | | | | | |
| FF_RX_D_0_7 | ff_rxdata_ch0[7] | | | | | | |
| FF_RX_D_0_8 | ff_rx_k_cntrl_ch0[0] | | | | NC | ff_rxdata_ch0[8] | |
| FF_RX_D_0_9 | ff_disp_err_ch0[0] | ff_rxstatus0_ch0[0] | ff_disp_err_ch0[0] | NC | ff_rxdata_ch0[9] | | |
| FF_RX_D_0_10 | ff_cv_ch0[0]] ³ | ff_rxstatus1_ch0[0] | ff_cv_ch0[0]] ³ | NC | | | |
| FF_RX_D_0_11 | NC | ff_rxstatus2_ch0[0] | ff_rx_even_ch0[0]] ⁴ | NC | | | |
| FF_RX_D_0_12 | ff_rxdata_ch0[8] | | | | | ff_rxdata_ch0[10] | |
| FF_RX_D_0_13 | ff_rxdata_ch0[9] | | | | | ff_rxdata_ch0[11] | |
| FF_RX_D_0_14 | ff_rxdata_ch0[10] | | | | | ff_rxdata_ch0[12] | |
| FF_RX_D_0_15 | ff_rxdata_ch0[11] | | | | | ff_rxdata_ch0[13] | |
| FF_RX_D_0_16 | ff_rxdata_ch0[12] | | | | | ff_rxdata_ch0[14] | |
| FF_RX_D_0_17 | ff_rxdata_ch0[13] | | | | | ff_rxdata_ch0[15] | |

Table 8-3. Data Bus Usage by Mode (Continued)

| Data Bus PCS Cell Name ⁵ | G8B10B | CPRI | PCI Express | GIGE | 8BSER | 10BSER | SDI |
|-------------------------------------|-----------------------------|---------------------|----------------------------------|------|-------------------|-------------------|-----|
| FF_RX_D_0_18 | ff_rxdata_ch0[14] | | | | | ff_rxdata_ch0[16] | |
| FF_RX_D_0_19 | ff_rxdata_ch0[15] | | | | | ff_rxdata_ch0[17] | |
| FF_RX_D_0_20 | ff_rx_k_cntrl_ch0[1] | | | | NC | ff_rxdata_ch0[18] | |
| FF_RX_D_0_21 | ff_disp_err_ch0[1] | ff_rxstatus0_ch0[1] | ff_disp_err_ch0[1] | NC | ff_rxdata_ch0[19] | | |
| FF_RX_D_0_22 | ff_cv_ch0[1]] ³ | ff_rxstatus1_ch0[1] | ff_cv_ch0[1]] ³ | NC | | | |
| FF_RX_D_0_23 | NC | ff_rxstatus2_ch0[1] | ff_rx_even_ch0[1]] ⁴ | NC | | | |

1. The force_disp signal will force the disparity for the associated data word on bits [7:0] to the column selected by the tx_disp_sel signal. If disp_sel is a one, the 10-bit code is taken from the 'current RD+' column (positive disparity). If the tx_disp_sel is a zero, the 10-bit code is taken from the 'current RD-' (negative disparity) column.
2. The auto-negotiation state machine generates the signal xmit. It is used to interact with the GIGE Idle State Machine in the hard logic.
3. When there is a code violation, the packet PCS 8b10b decoder will replace the output from the decoder with hex EE and K asserted (K=1 and d=EE is not part of the 8b10b coding space).
4. rx_even is a signal generated by the GIGE Link State Machine for the use of the GIGE Auto-negotiation and Receive State Machines (which is part of the IP core).
5. FF_TX_D_0_0: FPGA Fabric Transmit Data Bus Channel 0 Bit 0.

Control

Each mode has its own set of control signals which allows direct control of various PCS features from the FPGA logic. In general, each of these control inputs duplicate the effect of writing to a corresponding control register bit or bits. The ispLEVER[®] design tools give the user the option to bring these ports out to the FPGA interface.

Status

Each mode has its own set of status or alarm signals that can be monitored by the FPGA logic. In general, each of these status outputs correspond to a specific status register bit or bits. The ispLEVER design tools give the user the option to bring these port out to the PCS FPGA interface. Refer to the Mode Specific Control/Status Signals section for detailed information about control and status signals.

SCI (SERDES Client Interface) Bus

The SERDES Client Interface (SCI) is a soft IP that allow the SERDES/PCS Quad block to be controlled by registers as oppose to the configuration memory cells. It is a simple register configuration interface.

Using This Technical Note

The ispLEVER design tools from Lattice support all modes of the PCS. Most modes are dedicated to applications for a specific industry standard data protocol. Other modes are more general purpose modes which allow a user to define their own custom application settings. ispLEVER design tools allow the user to define the mode for each quad in their design. This document describes operation of the SERDES and PCS for all modes supported by ispLEVER. If you are using Lattice Diamond™ design software, see Appendix E.

This document provides a thorough description of the complete functionality of the embedded SERDES and associated PCS logic. Electrical and Timing Characteristics of the embedded SERDES are provided in the [LatticeECP2/M Family Data Sheet](#). Operation of the PCS logic is provided in the PCS section. A table of all status and control registers associated with the SERDES and PCS logic which can be accessed via the SCI Bus is provided in the Memory Map section. Package pinout information is provided in the Architecture section of the [LatticeECP2/M Family Data Sheet](#).

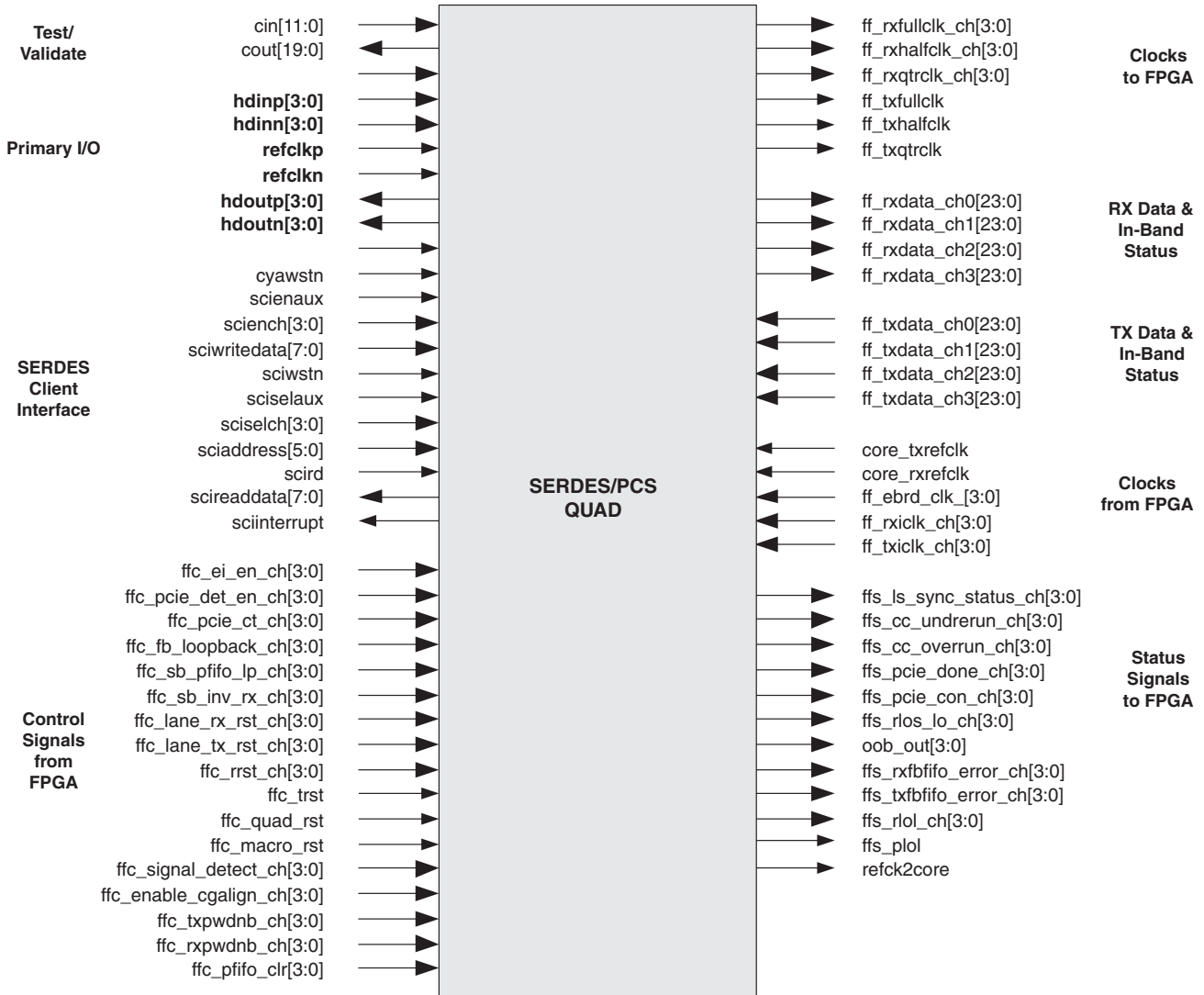
SERDES/PCS

The quad contains four channels with both Rx and Tx circuits, and an auxiliary channel that contains the Tx PLL. The reference clock to the Tx PLL can be provided either by the primary differential reference clock pins or by the FPGA core. The quad SERDES/PCS macro performs the serialization and de-serialization function for four lanes

of data. In addition, the PLL within the SERDES/PCS block provides the system clock for the FPGA logic. The quad also supports both full-data-rate and half-data-rate modes of operation on each Tx and Rx circuit independently.

The block level diagram is shown in Figure 8-4.

Figure 8-4. SERDES_PCS Block Signal Interface



I/O Definitions

Table 8-4 lists all default and optional input and outputs to/from a PCS quad. Users can choose optional ports for a PCS quad using the IPexpress™ GUI.

Table 8-4. SERDES_PCS I/O Descriptions

| Signal Name | I/O | Type | Description | Default/Optional |
|--|-----|---------|---|------------------|
| Primary I/O, SERDES Quad | | | | |
| hdinp0 | I | Channel | High-speed CML input, positive, channel 0 | D |
| hdinn0 | I | Channel | High-speed CML input, negative, channel 0 | D |
| hdinp1 | I | Channel | High-speed CML input, positive, channel 1 | D |
| hdinn1 | I | Channel | High-speed CML input, negative, channel 1 | D |
| hdinp2 | I | Channel | High-speed CML input, positive, channel 2 | D |
| hdinn2 | I | Channel | High-speed CML input, negative, channel 2 | D |
| hdinp3 | I | Channel | High-speed CML input, positive, channel 3 | D |
| hdinn3 | I | Channel | High-speed CML input, negative, channel 3 | D |
| hdoutp0 | O | Channel | High-speed CML output, positive, channel 0 | D |
| hdoutn0 | O | Channel | High-speed CML output, negative, channel 0 | D |
| hdoutp1 | O | Channel | High-speed CML output, positive, channel 1 | D |
| hdoutn1 | O | Channel | High-speed CML output, negative, channel 1 | D |
| hdoutp2 | O | Channel | High-speed CML output, positive, channel 2 | D |
| hdoutn2 | O | Channel | High-speed CML output, negative, channel 2 | D |
| hdoutp3 | O | Channel | High-speed CML output, positive, channel 3 | D |
| hdoutn3 | O | Channel | High-speed CML output, negative, channel 3 | D |
| refclkp | I | Quad | Reference Clock input, positive, Dedicated CML input | D |
| refclkn | I | Quad | Reference Clock input, negative, Dedicated CML input | D |
| Receive / Transmit Data Bus (See Table for Detailed Data Bus Usage) | | | | |
| ff_rxdata_ch0[23:0] | O | Channel | Data Signals for the channel 0 receive path | D |
| ff_rxdata_ch1[23:0] | O | Channel | Data Signals for the channel 1 receive path | D |
| ff_rxdata_ch2[23:0] | O | Channel | Data Signals for the channel 2 receive path | D |
| ff_rxdata_ch3[23:0] | O | Channel | Data Signals for the channel 3 receive path | D |
| ff_txdata_ch0[23:0] | I | Channel | Data Signals for the channel 0 transmit path | D |
| ff_txdata_ch1[23:0] | I | Channel | Data Signals for the channel 1 transmit path | D |
| ff_txdata_ch2[23:0] | I | Channel | Data Signals for the channel 2 transmit path | D |
| ff_txdata_ch3[23:0] | I | Channel | Data Signals for the channel 3 transmit path | D |
| Control Signals | | | | |
| ffc_sb_inv_rx_ch[3:0] | I | Channel | Control the inversion of received data. 1 = Invert the data 0 = Do not invert the data | O |
| ffc_enable_cgalgn_ch[3:0] ⁴ | I | Channel | Control comma aligner. 1 = Enable comma aligner 0 = Lock comma aligner at current position. | O |
| ffc_signal_detect_ch[3:0] ⁴ | I | Channel | Control Link State Machine 1 = Enable Link State Machine 0 = Disable Link State Machine | O |
| ffc_fb_loopback_ch[3:0] | I | Channel | FPGA Bridge Loopback. 1 = Enable loopback from Rx to Tx 0 = Normal data operation | O |

Table 8-4. SERDES_PCS I/O Descriptions (Continued)

| Signal Name | I/O | Type | Description | Default/Optional |
|--------------------------------------|-----|---------|---|------------------|
| ffc_sb_pfifo_lp_ch[3:0] | I | Channel | SERDES Bridge Parallel Loopback 1 = Enable loopback from Rx to Tx, 0 = Normal data operation | O |
| ffc_pfifo_clr_ch[3:0] | I | Channel | SERDES Bridge Parallel Loopback FIFO Clear 1 = Reset Loopback FIFO 0 = Normal Loopback operation | D |
| rx_sdi_en | I | Channel | These signals are used in BSCAN mode only. | O |
| tx_sdi_en | I | Quad | | |
| Reset Signals | | | | |
| ffc_lane_rx_rst_ch[3:0] | I | Channel | Active high, asynchronous input. Resets individual Rx channel logic only in PCS. | D |
| ffc_lane_tx_rst_ch[3:0] | I | Channel | Active high, asynchronous input. Resets individual Tx channel logic only in PCS. | D |
| ffc_rrst_ch[3:0] | I | Channel | Active high. Resets selected digital logic in the SERDES Receive channel | D |
| ffc_trst | I | Quad | Active high, resets selected digital logic in all SERDES Transmit channels. | D |
| ffc_quad_rst | I | Quad | Active high, asynchronous input. Resets all SERDES channels including the auxiliary channel and PCS. | D |
| ffc_macro_rst | I | Quad | Active high, asynchronous input to SERDES quad. Resets all SERDES channels including the AUX channel but not PCS logic. | D |
| ffc_txpwdnb_ch[3:0] | I | Channel | Active low transmit channel power down. 0 = Transmit Channel Power Down. | D |
| ffc_rxpwdnb_ch[3:0] | I | Channel | Active low receive channel power down. 0 = Receive Channel Power Down. | D |
| Status Signals | | | | |
| ffs_rlos_lo_ch[3:0] | O | Channel | Loss of signal detection for each channel. Register bits rlos_hset[2:0] are used to set the threshold. Low threshold is not user accessible. 1 = Loss of signal 0 = Signal detected | D |
| ffs_ls_sync_status_ch[3:0] | O | Channel | 1 = Lane is synchronous to commas. 0 = Lane has not found comma. | D |
| ffs_cc_underrun_ch[3:0] ⁶ | O | Channel | 1 = Receive clock compensator FIFO underrun error, 0 = No FFIFO errors. | O |
| ffs_cc_overrun_ch[3:0] ⁶ | O | Channel | 1 = Receive clock compensator FIFO overrun error 0 = No FIFO errors. | O |
| ffs_rxfbifo_error_ch[3:0] | O | Channel | 1 = Receive FPGA bridge FIFO error 0 = No FIFO errors | D |
| ffs_txfbifo_error_ch[3:0] | O | Channel | 1 = Transmit FPGA bridge FIFO error 0 = No FIFO errors. | D |
| ffs_rlol_ch[3:0] | O | Channel | 1 = Receive CDR loss of lock 0 = Lock maintained | D |
| ffs_plol | O | Quad | 1 = Transmit PLL loss of lock 0 = Lock maintained | D |
| oob_out_ch[3:0] ³ | O | Channel | Single ended outputs to video SERDES (in FPGA). | D |
| refck2core | O | Quad | Reference clock to FPGA core. | O |

Table 8-4. SERDES_PCS I/O Descriptions (Continued)

| Signal Name | I/O | Type | Description | Default/Optional |
|---|-----|---------|---|------------------|
| Clock Signals to FPGA | | | | |
| ff_rxfullclk_ch[3:0] | O | Channel | Receive channel recovered clock. In user mode, the source is always the channel's recovered clock. For standards such as GbE, 10 GbE that support clock compensation, the source is the respective transmit channel's system clock. For PCS bypass modes, it is also the Tx system clock, thus requiring raw mode to actually be done using either 8b10b mode with the 8b10b decoder disabled (10-bit or 20-bit data path). | D |
| ff_rxhalfclk_ch[3:0] | O | Channel | Receive channel recovered half clock. In 2:1 gearing mode, it is a divide-by-2 output. | D |
| ff_rxqtrclk_ch[3:0] | O | Channel | Receive channel recovered quarter clock. Available for further 2:1 gearing. | O |
| ff_txfullclk | O | Quad | Tx PLL full rate clock. | D |
| ff_txhalfclk | O | Quad | Tx PLL half clock. | D |
| ff_txqtrclk | O | Quad | Tx PLL quarter clock | O |
| Clock Signals from FPGA | | | | |
| core_rxrefclk | I | Quad | Rx Reference clock from FPGA logic, for CDR PLL | D |
| core_txrefclk | I | Quad | Tx Reference clock from FPGA logic, for Tx SERDES PLL | D |
| ff_ebrd_clk_[3:0] | I | Channel | Receive channel clock input from FPGA for CTC FIFO (Elastic Buffer) read | D |
| ff_rxiclck_ch[3:0] | I | Channel | Receive channel clock input from FPGA. Used to clock the Rx FPGA Interface FIFO with a clock synchronous to the reference and/or receive reference clock. | D |
| ff_txiclck_ch[3:0] | I | Channel | Transmit channel clock input from FPGA. Per channel transmit clock inputs from FPGA. Used to clock the Tx FPGA Interface FIFO with clock synchronous to the reference clock. Also used to clock the Rx FPGA Interface FIFO with a clock synchronous to the reference clock when CTC is used. | D |
| SERDES Client Interface (SCI) | | | | |
| scienaux | I | R | 1: sciwdata is written to the quad control registers 0: memory data is written to the quad control registers | O |
| scien_ch[3:0] | I | R | 1: sciwdata is written to the channel control registers 0: memory data is written to the channel control registers | O |
| sciselaux | I | R | 1: select quad registers | O |
| scisel_ch[3:0] | I | R | 1: select channel registers | O |
| sciaddress[5:0] | I | R | Address bus input | O |
| scireaddata[7:0] | O | R | Read data output | O |
| sciwritedata[7:0] | I | R | Write data input | O |
| scird | I | R | 1: Read data select 0: Read data not selected | O |
| sciwstn | I | R | Write strobe | O |
| sciinterrupt | O | R | Interrupt output | O |
| cyawstn ⁵ | I | R | 1: Copy all memory cells to registers if sciwstn = 0 0: Default | O |
| SERDES Characterization / Test Bus | | | | |
| cin[11:0] | I | R | Characterization test bus logic data input | D |

Table 8-4. SERDES_PCS I/O Descriptions (Continued)

| Signal Name | I/O | Type | Description | Default/Optional |
|-------------|-----|------|---|------------------|
| cout[19:0]] | O | R | Characterization test bus logic data output | D |

1. During configuration, both HDOUTP and HDOUTN are pulled high to VCCOB.
2. The Generic 8b10b PCS module includes four PCI control and status signals as options. If not used, the control signals may be tied to GND and the status signals may be left float.
3. The only way to get a signal out without using the CDR is to use the OOB_OUT signal. This signal is available in SDI mode only.
4. These signals appear in the PCS port list when the external link state machine is selected. Refer to Figure 8-28.
5. For factory use only.
6. These signals are pulses. In order to properly monitor these status signals, they must be latched.

SERDES/PCS Functional Description

Devices in the LatticeECP2M family have from one to four quads of embedded SERDES/PCS logic. Each quad, in turn, supports four independent full-duplex data channels. A single channel can support a data link and each quad can support up to four such channels. Note that mode selection is done on a per quad basis. For example, the selection of Gigabit Ethernet mode for a quad dedicates all four channels in that quad to Gigabit Ethernet mode.

The embedded SERDES CDR PLLs and Tx PLLs support data rates which cover a wide range of industry standard protocols.

Figure describes the major blocks and sub-blocks in a SERDES/PCS channel.

- SERDES
 - Equalizer
 - CDR (Clock and Data Recovery)
 - Deserializer
 - PreEmphasis
 - Serializer
 - Serial Loopback
- SERDES Bridge (SB)
 - Inverter: inverts receive data. Required by PCI Express
 - SERDES Bridge Parallel Loopback
- PCS Core
 - Word Alignment
 - 8b10b Decoder
 - 8b10b Encoder
 - Link State Machine
 - Elastic Buffer (CTC)
- FPGA Bridge (FB)
 - Down-sample FIFO
 - Up-sample FIFO
 - PCS Parallel Loopback

SERDES

Equalizer

As the data rate of digital transmission advances over Gbps, frequency-dependent attenuation results in severe intersymbol interference in the received signal and makes it mandatory to use equalizer in the data transceiver to recover data correctly. Three pole positions are provided: low, medium and high frequency range.

Pre-Emphasis

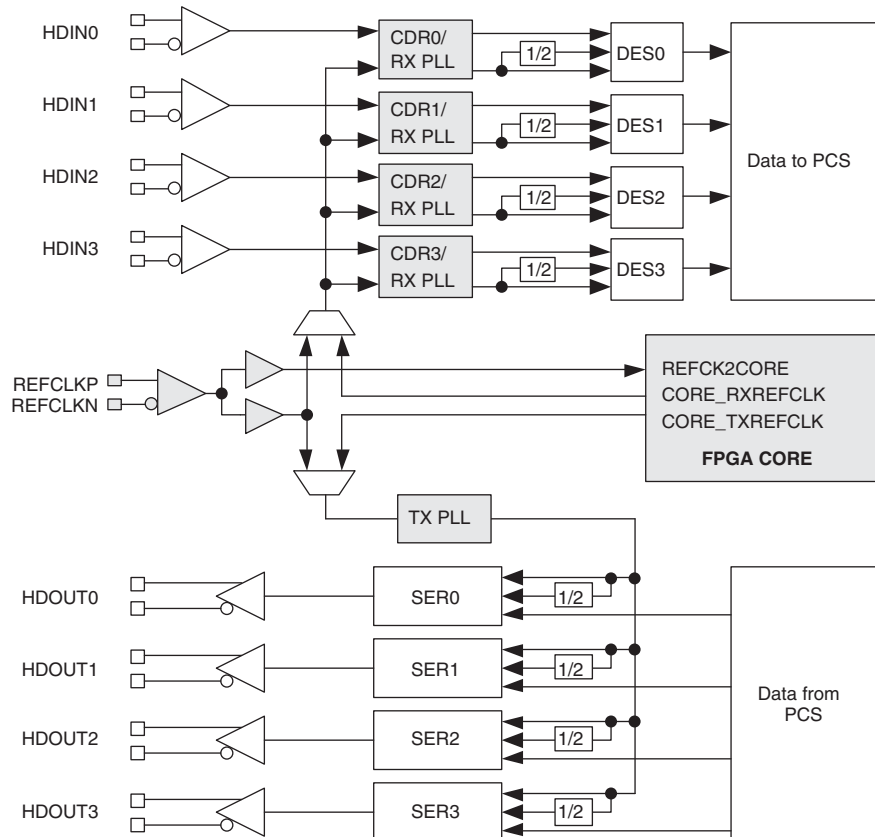
Pre-emphasis refers to a system process designed to increase the magnitude of some frequencies with respect to the magnitude of other frequencies. The goal is to improve the overall signal-to-noise ratio by minimizing the adverse effects of such phenomena as attenuation differences or saturation of recording media in subsequent parts of the system. User can select up to 80% of pre-emphasis.

Reference Clock Usage

One reference clock (REFCLK) is supported in the LatticeECP2M family. The Tx PLL and the four Rx PLLs all run at the same frequency, which is a multiple of the reference clock frequency. The Tx serializer in each channel can be independently programmed to run at this rate (full-data-rate mode) or half of this rate (half-data-rate mode). Similarly, the Rx deserializer in each channel can be independently programmed to run at this rate (full-data-rate mode) or half of this rate (half-data-rate mode). If all Tx and Rx are programmed in the same mode (normally this will be full-rate) then all four channels in the quad will run at the same frequency, both Tx and Rx.

The transmit PLL in the SERDES is able to lock to either an external reference clock from the pins, or a reference clock provided from the FPGA core (core_txrefclk). The receive CDRs in the SERDES is able to lock to either an external reference clock from the pins, or a reference clock provided by the FPGA core (core_rxrefclk).

Figure 8-5. Block Diagram, Reference Clock Usage



Reference Clock Sources

refclkp, refclkn

Dedicated CML input. This is the first choice unless different clock sources for rx and tx are used. The clock signal may be CML, LVDS or LVPECL. Refer to TN1114, [Electrical Recommendations for Lattice SERDES](#), for example interface circuits.

core_rxrefclk, core_txrefclk

Reference clock from FPGA logic. The Primary Clock pad (PCLK) should be used as the clock input pin to the FPGA. The clock signal may be CML, LVDS, LVPECL or single-ended.

FPGA PLL

When an FPGA PLL is used as the reference clock, the reference clock to PLL should be assigned to a dedicated PLL input pad. The FPGA PLL output jitter may not meet system specifications at higher data rates. Use of an FPGA PLL is not recommended in jitter-sensitive applications.

Full-Data-Rate and Half-Data-Rate

Each Tx Serializer and Rx Deserializer can be split into full-data-rate and half-data-rate, allowing two different data rates in each direction and in each channel.

The Channel Based Protocol Mode must be selected to use this dual rate feature.

Example:

1. In the **Quad Tab window** of IPexpress (Figure 8-22), **G8B10B Mode, Channel Based Protocol Mode, Channel 0 (Full Rate) and Channel 1 (Half Rate)** are selected.
2. In the **Reference Clock (CM) window** (Figure 8-24), under the **Full Rate Channel** column, enter the following:
 - Serial Bit Clock Rate: 2.5 GHz
 - Reference Clock Multiplier: 10X
 - Leave the other three entries
3. The **Half Rate Channel** column will display calculated values for Half Rate:

| | Full Rate Channel | Half Rate Channel |
|--------------------------------------|--------------------------|--------------------------|
| Serial Bit Clock Rate | 2.5 GHz | 1.25 GHz |
| Reference Clock Multiplier | 10X | 5X |
| Calculated Reference Clock Rate | 250 MHz | 250 MHz |
| FPGA Interface Data Bus Width | 8 | 8 |
| Calculated FPGA Interface Clock Rate | 250 MHz | 125 MHz |

Full Clock, Half Clock and Quarter Clock Usage

In most cases, txfullclk is used for ff_rxiclk_chx, ff_txiclk_chx, ff_ebrd_clk_x as illustrated in Figure 8-32.

The IPexpress GUI automatically calculates the FPGA Interface Clock Frequency when Reference Clock Multiplier and FPGA Interface Data Bus Width is selected.

Table 8-5 illustrates clock usage examples in all possible combinations of the refclk_multiplier modes and 8-bit or 16-bit interface Data Bus widths.

Table 8-5. Clock Usage Example – G8B10B Mode, REFCLK = 120MHz

| Reference Clock Multiplier | 10xH | 10x | 20xH | 20x |
|---------------------------------|-------------------|----------|----------|----------|
| Bit Rate | 600 Mbps | 1.2 Gbps | 1.2 Gbps | 2.4 Gbps |
| 8-Bit Interface Example | | | | |
| rxfullclk ¹ | 60 | 120 | 120 | 240 |
| rxhalfclk | 30 | 60 | 60 | 120 |
| txfullclk | 120 | 120 | 240 | 240 |
| txhalfclk | 60 | 60 | 120 | 120 |
| txqtrclk | 30 | 30 | 60 | 60 |
| 16-Bit Interface Example | | | | |
| rxfullclk | 60 | 120 | 120 | 240 |
| rxhalfclk ¹ | 30 | 60 | 60 | 120 |
| txfullclk | 120 | 120 | 240 | 240 |
| txhalfclk | 60 | 60 | 120 | 120 |
| txqtrclk | 30 ^{2,3} | 30 | 60 | 60 |

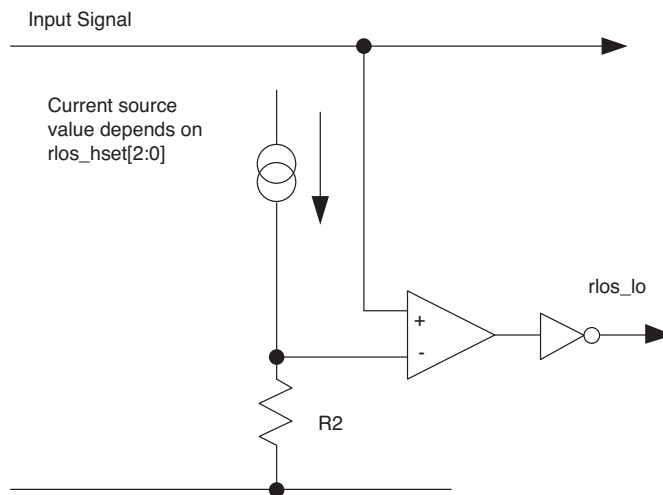
1. These recovered clocks are used as the source of rxiclck in CTC BYPASS mode. See Figures 8-34 and 8-36.
2. The clocks in the shaded cells are used as the FPGA interface clocks in each mode.
3. When this mode is selected, the 'PLL Quarter Clock' must be checked in the Optional Port tab window of the configuration GUI (see Figure 8-28).

The VCO in the Full Data Rate Channel is the same as the bit clock. In Half Data Rate Channel, the bit clock is half of the VCO.

Loss Of Signal (LOS)

Each channel contains a programmable loss-of-signal detector as shown in Figure 8-6. The loss-of-signal threshold depends on the value of the programmable current source. The current source value is chosen using the rlos_hset[2:0] control bits.

Figure 8-6. Loss-of Signal Detector



Reference voltage on this node is derived from VCM

Note: rlos_lset[2:0] control bits and associated status bits are internal use only.

Loss Of Lock

Both the transmit PLL and the individual channel CDRs have digital counter-based, loss-of-lock detectors. If the transmit PLL loses lock, the loss-of-lock for the PLL is asserted and remains asserted until the PLL reacquires lock.

If a CDR loses lock, the loss-of-lock for that channel is asserted and locking to the reference clock retrains the VCO in the CDR. When this is achieved, loss-of-lock for that channel is de-asserted and the CDR is switched back over to lock to the incoming data. The CDR will either remain locked to the data, or will go back out of lock again in which case the re-training cycle will repeat.

Tx Lane-to-Lane Skew

A control bit, `sync_toggle`, has been added to reset all the active Tx channels to start serialization with bit0. Most multi-channel protocol standards have requirements to ensure that the Tx lane-to-lane skew is within a certain specification. This is to ensure that most of the Rx De-skew (Multi-channel alignment, which is not supported in hard PCS by Lattice ECP2M) is for channel (trace) de-skewing.

The reset to the Tx serializers is generated either by toggling the `sync_toggle` control bit or by a transition in PLL Loss of Lock. The reset is applied to all active Tx serializers. If both these source signals are level, then the Tx serializers are operating normally.

PCS Functional Setup

The LatticeECP2M PCS can be configured for use in various applications. Setup is chosen with the ispLEVER® IPexpress module generation tool which allows the user to select the mode and feature options for the PCS. Option selections are saved in an auto-configuration file which is subsequently used by the ispLEVER bitstream generator to write the user selections into the bitstream. To change PCS option selections it is recommended that the user re-run IPexpress to regenerate a PCS module and create a new auto-configuration file. Some options can be changed by manually editing the auto-configuration file before running the bitstream generator.

After configuration, PCS options can be changed dynamically by writing to PCS registers via the optional SERDES Client Interface (SCI) bus. The SERDES Client Interface is soft IP that allows the SERDES/PCS quad to be controlled by registers as opposed to configuration memory cells. A table of control and status registers accessible through the SCI is provided in the Memory Map section of this document.

Auto-Configuration File

Initial register setup for each PCS mode can be performed by using the autoconfiguration feature in ispLEVER. The module generator provides an auto-configuration file which contains the quad and channel register settings for the chosen mode. This file can be referred to for front-end simulation and also can be integrated into the bitstream. When an auto-configuration file is integrated into the bitstream all the quad and channel registers will be set to values defined in the auto-configuration file during configuration. The SCI (SERDES Client Interface) is therefore not needed if all quads are to be set via auto-configuration files. However, the SCI must be included in a design if the user needs to change control registers or monitor status registers during operation.

Transmit Data

The PCS quad transmit data path consists of 8b10b Encoder and Serializer per channel.

8b10b Encoder

This module implements an 8b10b encoder as described within the IEEE 802.3ae-2002 1000BASE-X specification. The encoder performs the 8-bit to 10-bit code conversion as described in the specification, along with maintaining the running disparity rules as specified. The 8b10b encoder can be bypassed on a per channel basis by setting the attribute `CHx_8B10B` to "BYPASS" where x is the channel number.

Serializer

The 8b10b encoded data undergoes parallel to serial conversion and is transmitted off chip via the embedded SERDES.

Receive Data

The PCS quad receive data path consists of the following sub-blocks per channel: Deserializer, Word Aligner, 8b10b Decoder, Optional Link State Machine, and Optional Receive Clock Tolerance Compensation (CTC) FIFO.

Deserializer

Data is brought on-chip to the embedded SERDES where it goes from serial to parallel.

Word Alignment (Byte Boundary Detect)

This module performs the comma codeword detection and alignment operation. The comma character is used by the receive logic to perform 10-bit word alignment upon the incoming data stream. The word aligner can be bypassed on a per channel basis by setting attribute CHx_COMMA_ALIGN to "BYPASS" where x is the channel number. The comma description can be found in section 36.2.4.9 of the 802.3.2002 1000BASE-X specification as well as section 48.2.6.3, Figure 48-7 of the 10GBASE-X specification.

A number of programmable options are supported within the word alignment module:

- Software enable control (in User Configured - UC mode).

Note: UC_Mode refers to 8-bit SERDES Only, 10-bit SERDES Only, SD-SDI, HD-SDI.

- Ability to set two programmable word alignment characters (typically one for positive and one for negative disparity) and a programmable per bit mask register for alignment compare. Alignment characters and the mask register is set on a per quad basis. For many protocols, the word alignment characters can be set to "XXX000011" (jhgfi edcba bits for positive running disparity comma character matching code groups K28.1, K28.5, and K28.7) and "XXX1111100" (jhgfi edcba bits for negative running disparity comma character matching code groups K28.1, K28.5, and K28.7). However the user can define any bit pattern up to 10 bits long.
- The first alignment character is defined by the 10-bit value assigned to attribute COMMA_A. This value applies to all channels in a PCS quad.
- The second alignment character is defined by the 10-bit value assigned to attribute COMMA_B. This value applies to all channels in a PCS quad.
- The mask register defines which word alignment bits to compare (a '1' in a bit of the mask register means check the corresponding bit in the word alignment character register). The mask registers defined by the 10-bit value assigned to attribute COMMA_M. This value applies to all channels in a PCS quad.

When attribute CHx_COMMA_ALIGN is set to 'AUTO', one of the protocol based Link State machines will control word alignment. For more information on the operation of the protocol based Link State Machines, see the Protocol Specific Link State Machine description below.

8b10b Decoder

The 8b10b decoder implements an 8b10b decoder operation as described with the IEEE 802.3-2002 specification. The decoder performs the 10-bit to 8-bit code conversion along with verifying the running disparity. The 8b10b decoder can be bypassed on a per channel basis by setting attribute CHx_8B10B to "BYPASS" where x is the channel number.

When a code violation is detected, the ff_rxdata receive data is set to 0xEE with ff_rx_k_cntrl_ch set to '1'.

Protocol Specific Link State Machine

The PCS implements link state machines for various protocols that are used in various quad modes.

When a protocol specific Link State Machine is selected, that channel's Link State Machine must be enabled by setting the protocol CH(0-3)_COMMA_ALIGN to "AUTO". Selection of the specific Link State Machine that is enabled in each mode is described below and summarized in Figure 8-7.

The Link State Machine for Gigabit Ethernet is selected when attribute PROTOCOL is "GIGE". Link synchronization is achieved after the successful detection and alignment of the required number of consecutive aligned code words. The Gigabit Ethernet link synchronization state machine implements the Synchronization State Diagram shown in Figure 36-9 of the 802.3- 2002 1000BASE-X specification.

In '8B10B' and '10-bit SERDES Only' protocols, the Gigabit Ethernet Link State Machine is used when COMMA_ALIGN is set to 'AUTO'.

External Link State Machine Option

When attribute CHx_COMMA_ALIGN is set to “DYNAMIC”, the protocol specific Link State Machines are bypassed. When ffc_enable_cgalign_ch(0-3) is high, the word aligner will lock alignment and stay locked. It will stop comparing incoming data to the user-defined word alignment characters and will maintain current alignment on the first successful compare to either the COMMA_A or COMMA_B. When ffc_enable_cgalign_ch(0-3) is pulsed low, the word aligner will re-lock on the next match to one of the user-defined word alignment characters. If desired, ffc_enable_cgalign_ch(0-3) can be controlled by a Link State Machine implemented externally to the PCS quad to allow a change in word alignment only under specific conditions.

Figure 8-7 illustrates the link state machine options.

Figure 8-7. PCS Word Aligner and Link State Machine Options

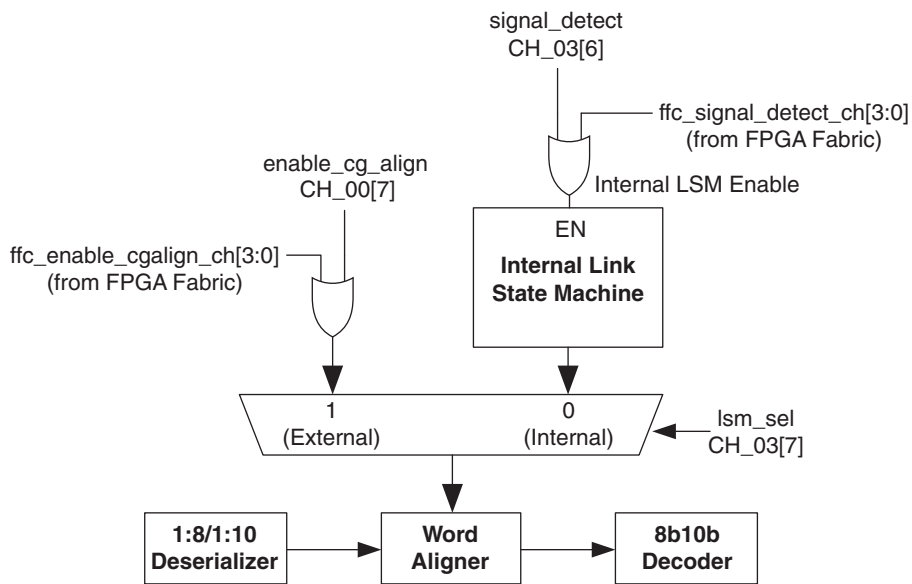


Table 8-6. Link State Machine and Word Aligner Selection

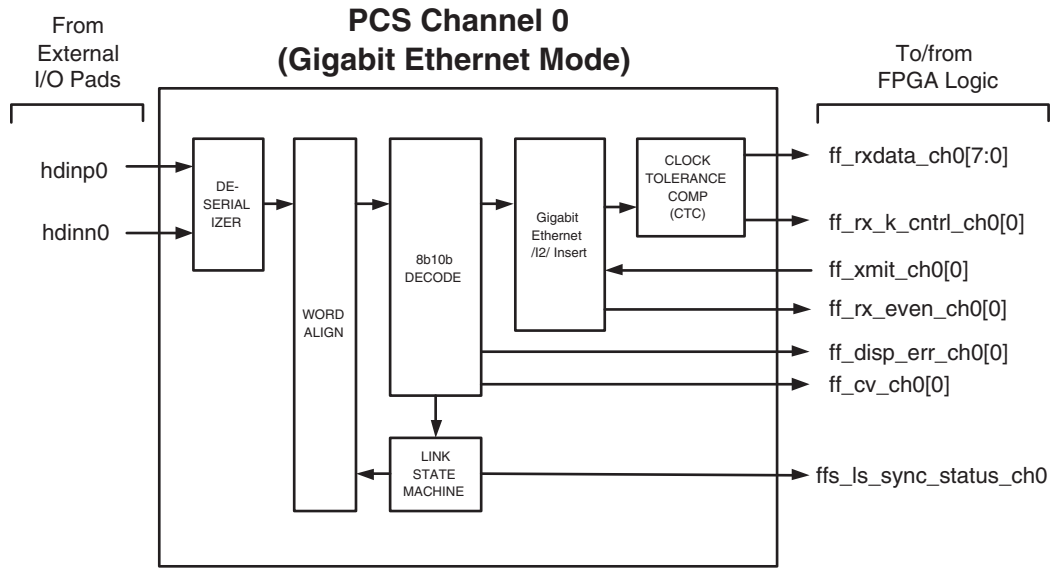
| COMMA ALIGN Mode | Description |
|------------------|--|
| AUTO | WA enabled, LSM enabled (GbE LSM: default). |
| DYNAMIC | WA enabled, LSM disabled. The cg_align and sig_detect signals are set to 0 so that the potential external LSM to control both signals. The External Link State Machine option in the Optional Port tab of the GUI must be also selected. |
| BYPASS | WA bypassed, LSM disabled. Users may develop word aligner in the FPGA core and provide their own cg_align and sig_detect signals to the logic. |

When a Link State Machine is selected and enabled, for a particular channel, that channel's ffs_ls_sync_status_ch(0-3) status signal will go high upon successful link synchronization.

Idle Insert for Gigabit Ethernet Mode

Generic 8b10b mode also has the option to select the Link State Machine for word alignment. The PCS set to Gigabit Ethernet Mode provides for insertion of /I2/ symbols into the receive data stream for auto-negotiation. Gigabit Ethernet auto-negotiation is performed in soft logic. This function inserts a sequence of 8 /I2/ ordered sets every 2048 clock cycles. /I2/ insertion is controlled by the ff_xmit_ch(0-3) input to the PCS which is driven from the auto-negotiation soft logic. The signal ff_rx_even_ch(0-3)[0] from the PCS to the auto-negotiation soft logic is also provided. Figure 8-8 shows one channel (channel 0 in this example) of receive logic when the PCS is set to Gigabit Ethernet Mode showing these control/status signals.

Figure 8-8. PCS Receive path for Gigabit Ethernet Mode (Channel 0 Example)



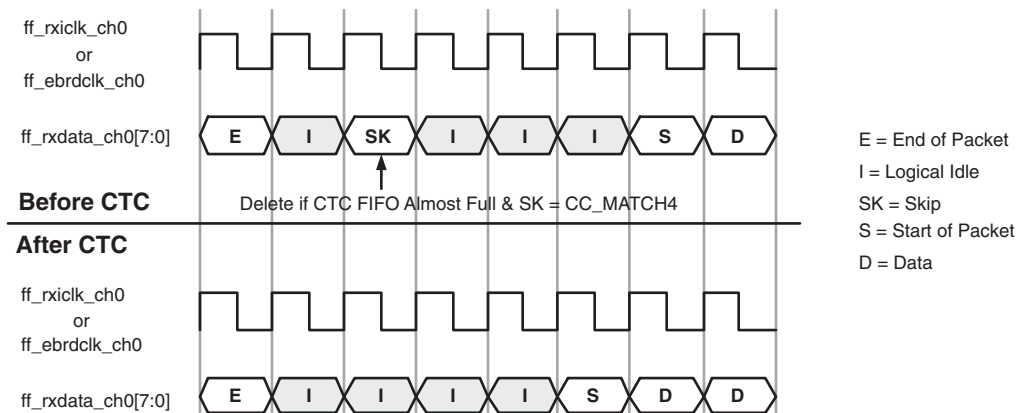
Clock Tolerance Compensation

The Clock Tolerance Compensation module performs clock rate adjustment between the recovered receive clocks and the locked reference clock. Clock compensation is performed by inserting or deleting bytes at pre-defined positions, without causing loss of packet data. A 16-Byte elasticity FIFO is used to transfer data between the two clock domains and will accommodate clock differences of up to the specified ppm tolerance for the LatticeECP2M SERDES (See DC and Switching Characteristics section of the [LatticeECP2/M Family Data Sheet](#)).

A channel has the Clock Tolerance Compensation block enable when that channel's attribute `CHx_CTC_BYP` is set to "NORMAL". The CTC is bypassed when that channel's attribute `CHx_CTC_BYP` is set to "BYPASS".

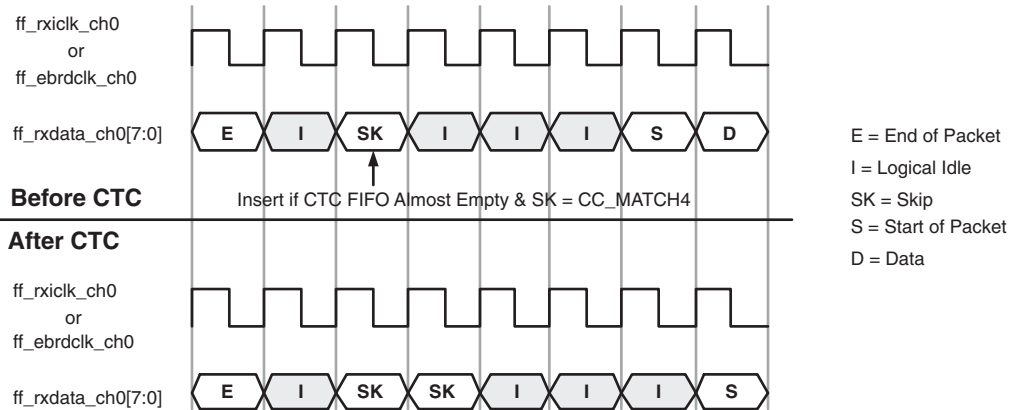
A diagram illustrating 1 byte deletion is shown in Figure 8-9:

Figure 8-9. Clock Tolerance Compensation 1 Byte Deletion Example



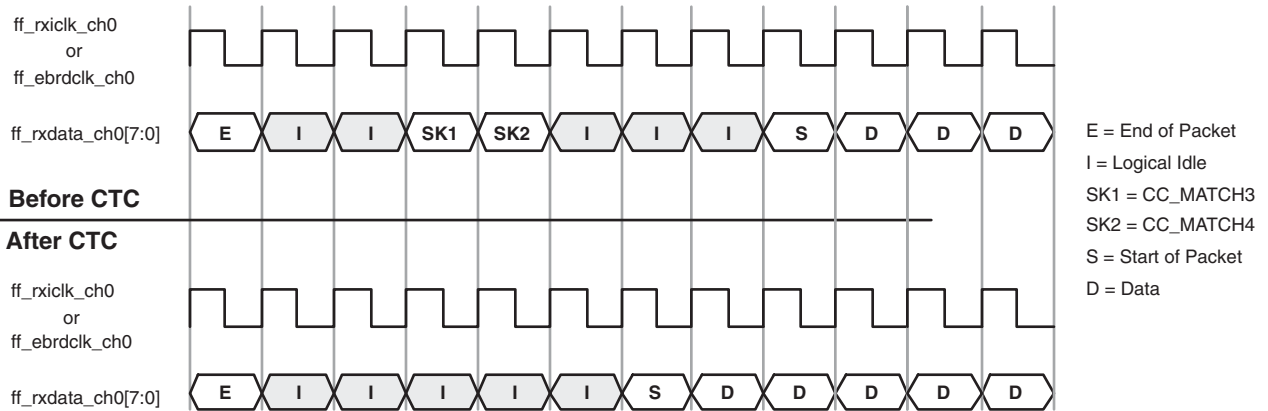
A diagram illustrating 1 byte insertion is shown in Figure 8-10:

Figure 8-10. Clock Tolerance Compensation 1 Byte Insertion Example



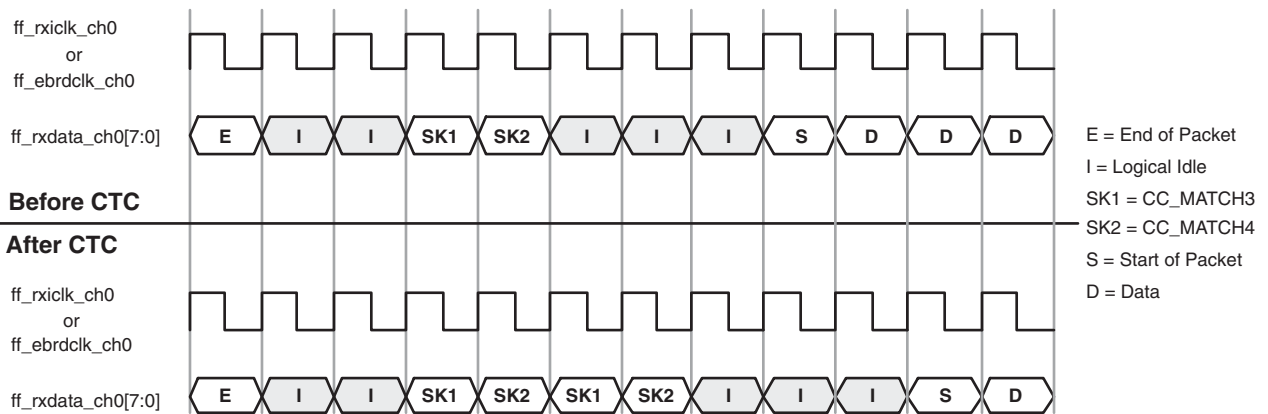
A diagram illustrating 2 byte deletion is shown in Figure 8-11:

Figure 8-11. Clock Tolerance Compensation 2 Byte Deletion Example



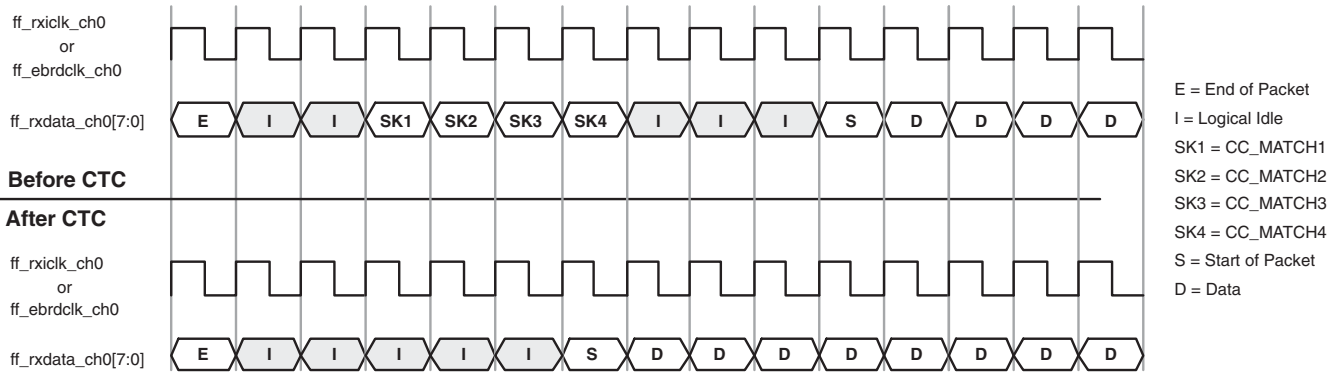
A diagram illustrating 2 byte insertion is shown in Figure 8-12:

Figure 8-12. Clock Tolerance Compensation 2 Byte Insertion Example



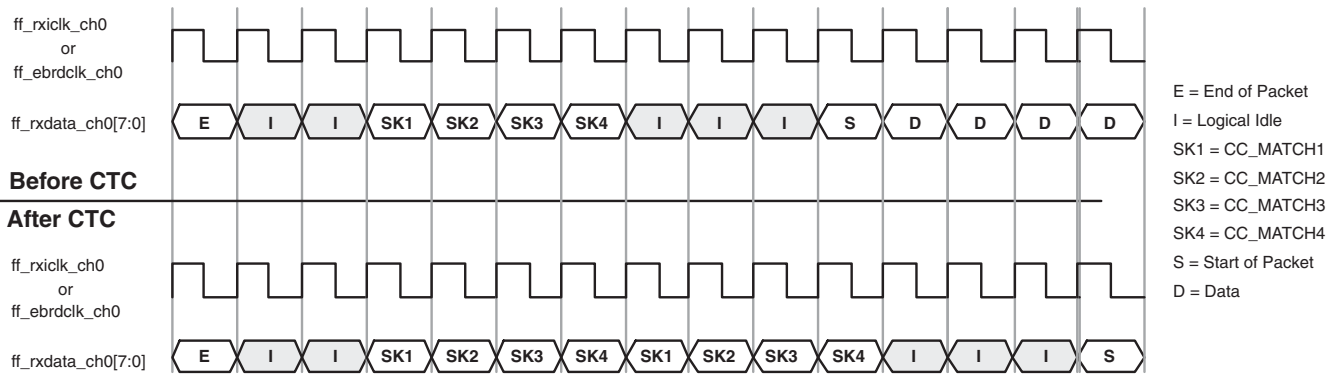
A diagram illustrating 4 byte deletion is shown in Figure 8-13:

Figure 8-13. Clock Tolerance Compensation 4 Byte Deletion Example



A diagram illustrating 4 byte insertion is shown in Figure 8-14:

Figure 8-14. Clock Tolerance Compensation 4 Byte Insertion Example



Clock compensation values are set on a quad basis. The CTC can be bypassed on a per channel basis by setting attribute CHx_CTC_BYP to “BYPASS” where x is the channel number. Setting CHx_CTC_BYP to “NORMAL” means the CTC is active. In the ispLEVER module generator, defining a channel as “Single” creates an auto-configuration file which enables CTC. Defining a channel as “MCA Group1” or “MCA Group 2” creates an auto-configuration file which bypasses CTC. When the CTC is used, the following settings for clock compensation must be set as appropriate for the intended application:

- Set the insertion/deletion pattern length using the CC_MATCHMODE attribute. This sets the number of skip bytes the CTC compares to before performing an insertion or deletion. Values for CC_MATCHMODE are “MATCH_4” (1 byte insertion/deletion), “MATCH_3_4” (2 bytes insertion/deletion), and “MATCH_1_2_3_4” (4 bytes insertion/deletion) to 1. The minimum inter-packet gap must also be set as appropriate for the targeted application. The inter-packet gap is set by assigning values to attribute CC_MIN_IPG. Allowed values for CC_MIN_IPG are “0”, “1”, “2”, and “3”. The minimum allowed inter-packet gap after skip character deletion is performed based on these attribute settings is described in Table 8-7 below.
- The Skip byte or ordered set must be set corresponding to the CC_MATCHMODE chosen. For 4 byte insertion/deletion (CC_MATCHMODE = “MATCH_1_2_3_4”), the first byte must be assigned to attribute MATCH_1, the second byte must be assigned to attribute MATCH_2, the third byte must be assigned to attribute MATCH_3, and the fourth byte must be assigned to attribute MATCH_4. Values assigned are 10 bit binary values. For example, if a 4 byte skip ordered set is /K28.5/D21.4/D21.5/D21.5, then “MATCH_1” should be “0110111100”, “MATCH_2” = “0010010101”, and “MATCH_3” = “MATCH_4” = “0010110101”. For 2 byte insertion/deletion (CC_MATCHMODE = “MATCH_3_4”), the first byte must be assigned to attribute MATCH_3, and the second byte must be assigned to attribute MATCH_4. For 1 byte insertion/deletion (CC_MATCHMODE = “MATCH_4”), the skip byte must be assigned to attribute MATCH_4.

- The clock compensation FIFO high water and low water marks must be set to appropriate values for the targeted protocol. Values can range from 0 to 15 although the high water mark must be set to a value higher than or equal to the low water mark. The high water mark is set by assigning a value to attribute CCHMARK. Allowed values for CCHMARK are hex values ranging from “0” to “F”. The low water mark is set by assigning a value to attribute CCLMARK. Allowed values for CCLMARK are hex values ranging from “0” to “F”.
- Clock compensation FIFO overrun can be monitored on a per channel basis on the PCS/FPGA interface port labeled ffs_cc_overrun_ch(0-3) if “Error Status Ports” is selected when generating the PCS block with the isp-LEVER module generator.
- Clock compensation FIFO underrun can be monitored on a per channel basis on the PCS/FPGA interface port labeled ffs_cc_underrun_ch(0-3) if “Error Status Ports” is selected when generating the PCS block with the isp-LEVER module generator.

Calculating Minimum Inter-packet Gap

Table 8-7 shows the relationship between the user-defined values for inter-packet gap (defined by the CC_MIN_IPG attribute), and the guaranteed minimum number of bytes between packets after a skip character deletion from the PCS. The table shows the inter-packet gap as a multiplier number. The minimum number of bytes between packets is equal to the number of bytes per insertion/deletion times the multiplier number shown in the table. For example, if the number of bytes per insertion/deletion is 4 (CC_MATCHMODE is set to “MATCH_1_2_3_4”), and the minimum inter-packet gap attribute C_MIN_IPG is set to “2”, then the minimum inter-packet gap is equal to 4 (CC_MATCHMODE = “MATCH_1_2_3_4”) times 2 (Table 8-7 with CC_MIN_IPG = “2”) or 8 bytes. The PCS will not perform a skip character deletion until the minimum number of inter-packet bytes have passed through the CTC.

Table 8-7. Minimum Inter-packet Gap Multiplier

| CC_MIN_IPG | Insertion/Deletion Multiplier Factor |
|------------|--------------------------------------|
| “0” | 1 X |
| “1” | 2 X |
| “2” | 3 X |
| “3” | 4 X |

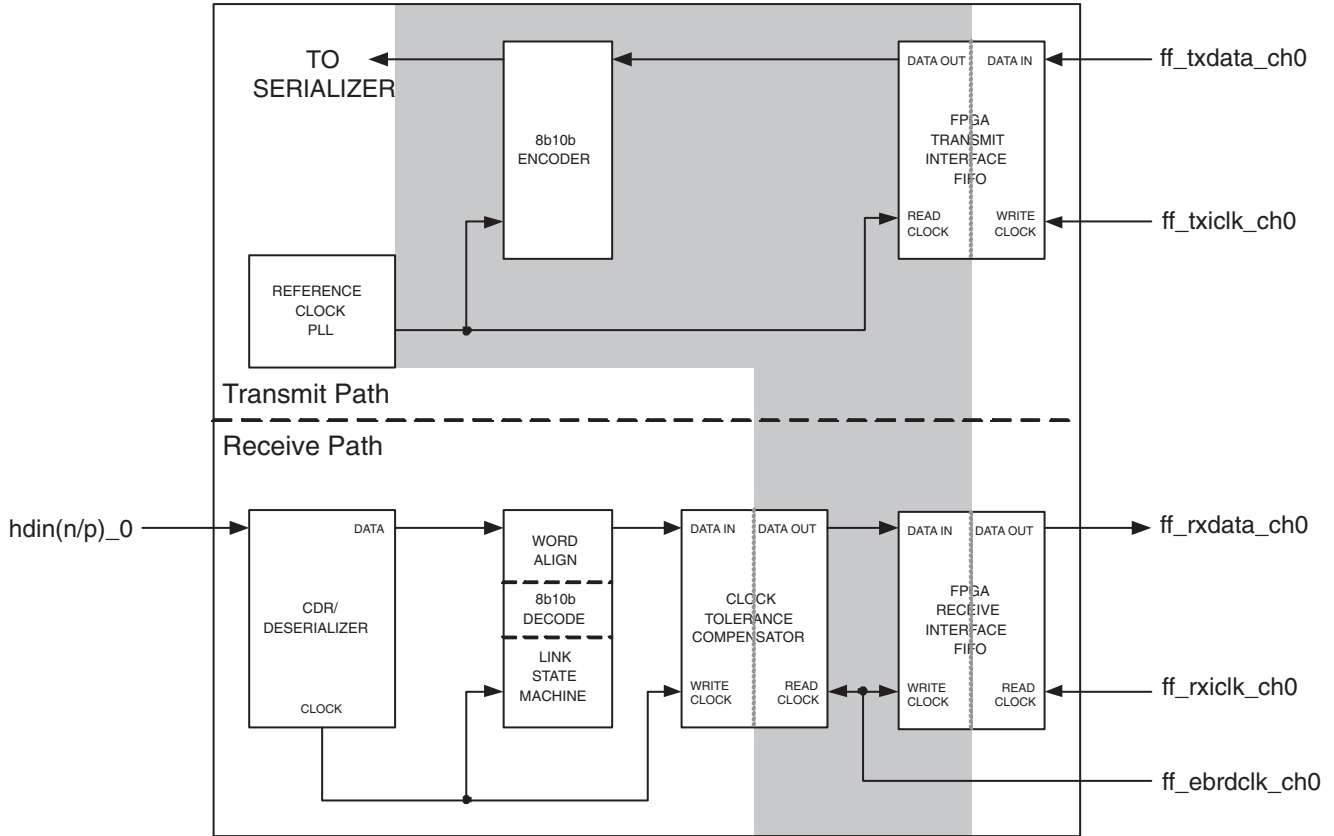
Clock Domains

Figure 8-15 shows the clock domains for both transmit and receive directions for a single channel inside the PCS for modes which utilize the Clock Tolerance Compensation (CTC) block.

On the transmit side, a clock domain transfer from the ff_txiclck_ch input at the FPGA interface to the locked reference clock occurs in the FPGA Transmit Interface FIFO. The FPGA Transmit Interface FIFO is intended to adjust for phase differences between two clocks which are of the same frequency only. These FIFOs (one per channel) cannot compensate for frequency variations.

On the receive side, a clock domain transfer occurs from the channel recovered clocks to the locked reference clock at the Clock Tolerance Compensator (CTC) block. The CTC can adjust for frequency differences between the recovered receive clock and the reference clock up to the maximum phase difference specification for the LatticeECP2M. Downstream from the CTC, another clock interface occurs between the locked reference clock and the ff_rxiclck_ch at the FPGA Receive Interface FIFO. The FPGA Receive Interface FIFO is intended to adjust for phase differences between two clocks which are of the same frequency only. The FPGA Receive Interface FIFOs (one per channel) cannot compensate for frequency variations.

Figure 8-15. PCS Clock Domain Transfers for CTC Modes



To guarantee a synchronous interface, both the input transmit clocks and input receive clock should be driven from one of the output reference clocks for a PCS quad set to Generic 8b10b mode. Figure 8-16 illustrates the possible connections that would result in a synchronous interface.

Figure 8-16. Synchronous Input Clocks to PCS Quad with CTC Used

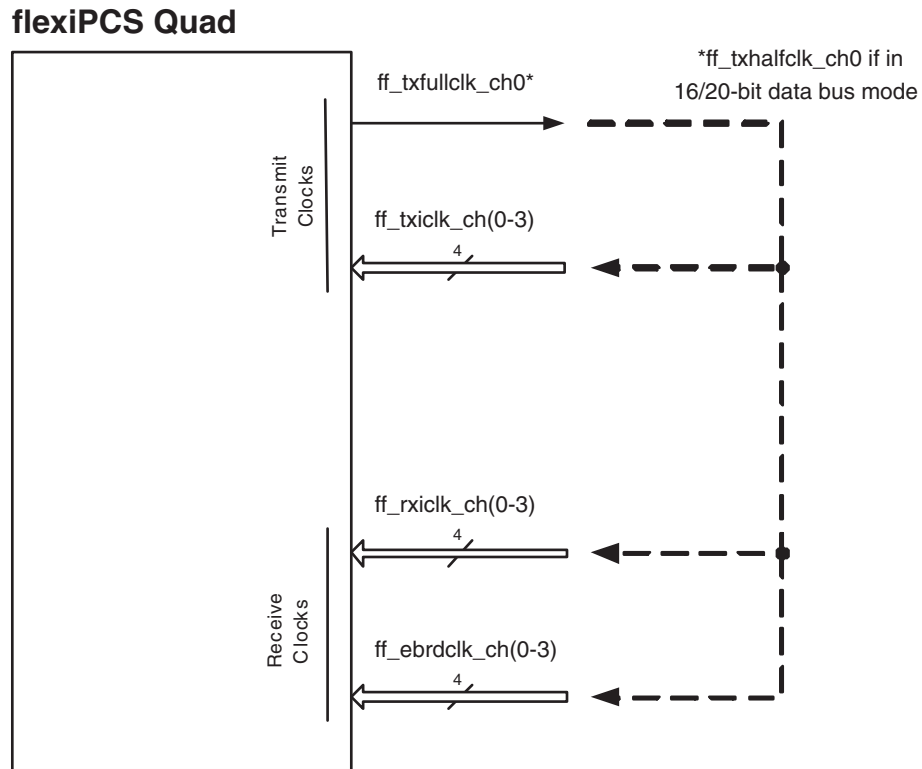
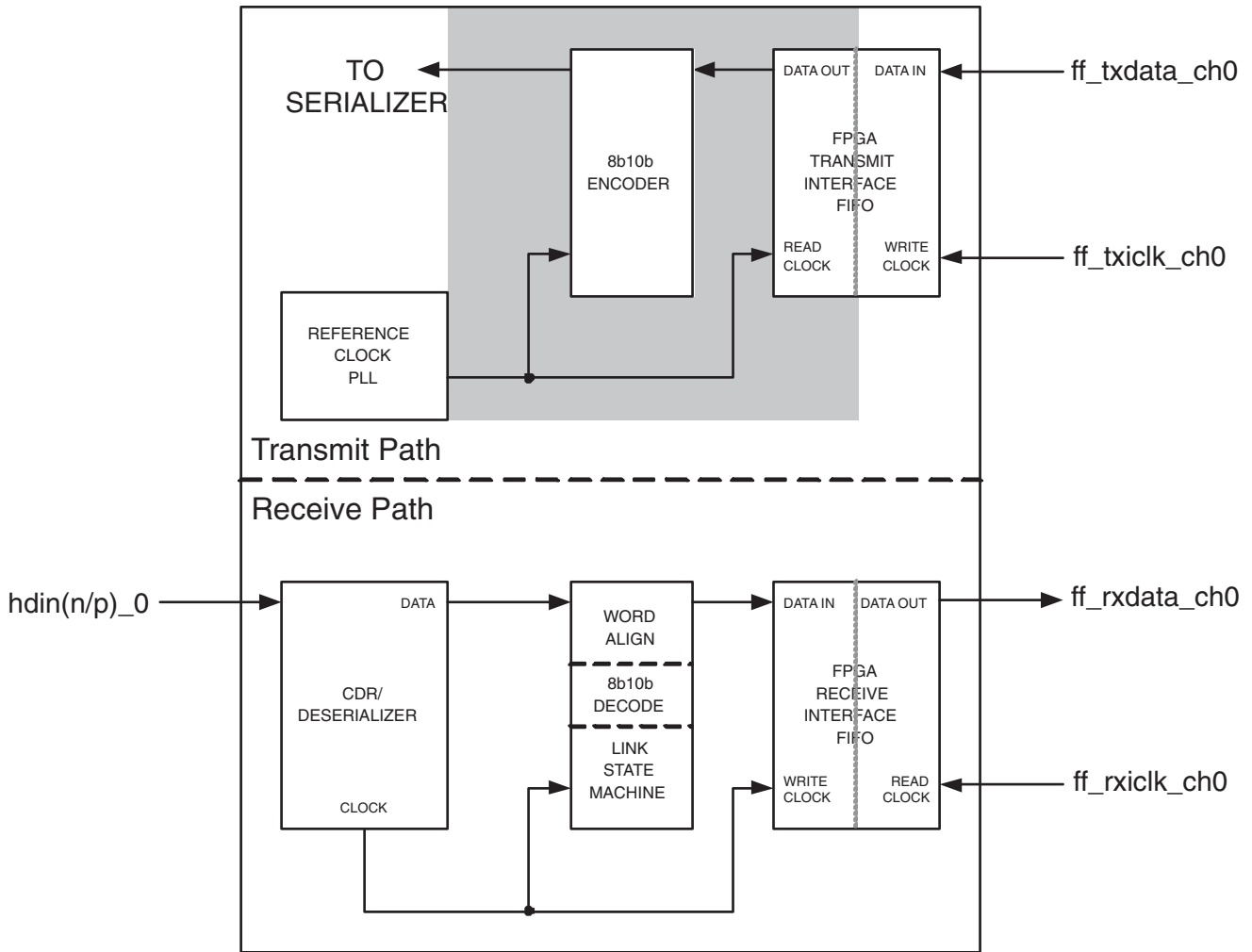


Figure 8-17 shows the clock domains for both transmit and receive directions for a single channel inside the PCS which do not utilize the Clock Tolerance Compensation (CTC) block.

On the transmit side, a clock domain transfer from the `ff_txiclk_ch` input at the FPGA interface to the locked reference clock occurs in the FPGA Transmit Interface FIFO. The FPGA Transmit Interface FIFO is intended to adjust for phase differences between two clocks which are of the same frequency only. These FIFOs (one per channel) cannot compensate for frequency variations.

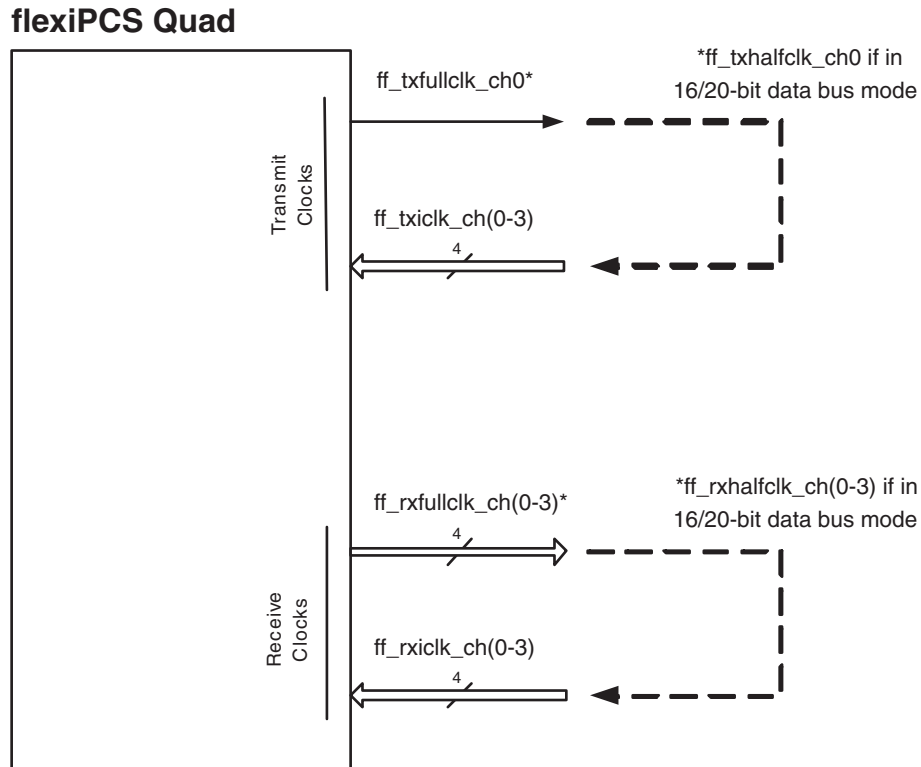
On the receive side, a clock domain transfer occurs between the recovered receive clock and the `ff_rxiclk_ch` at the FPGA Receive Interface FIFO. The FPGA Receive Interface FIFO is intended to adjust for phase differences between two clocks which are of the same frequency only. The FPGA Receive Interface FIFOs (one per channel) cannot compensate for frequency variations.

Figure 8-17. PCS Clock Domain Transfers for Non-CTC Modes



To guarantee a synchronous interface, both the input transmit clocks and input receive clock should be driven from one of the output reference clocks for a PCS quad set to Generic 8b10b mode. Figure 8-18 illustrates the possible connections that would result in a synchronous interface.

Figure 8-18. Synchronous Input Clocks to PCS Quad without CTC



Spread Spectrum Clocking (SSC) Support

LatticeECP2M SERDES/PCS does not have a Spread Spectrum generator but it can receive Spread Spectrum data.

SSC support in LatticeECP2M applies to all protocols that require similar support. The ports on the two ends of Link must transmit data at a rate that is within 600ppm of each other at all times. This is specified to allow bit-rate clock source with a +/- 300ppm tolerance. The data rate can be modulated from +0% to -0.5% of the nominal data rate, at a modulation rate in the range of 30KHz to 33KHz. Along with the +/- 300ppm tolerance limit, both ports require the same bit rate clock when the data is modulated with an SSC.

The root complex is responsible for spreading the reference clock. The endpoint then uses that same clock to pass back the spectrum through the TX. Thus, there is no need for a separate RXREFCLK.

A predominant application of this is the add-in card. Add-in cards are not required to use the REFCLK from the connector but must receive and transmit with the same SSC as the PCI Express connector REFCLK.

Serial Digital Video and Out-Of-Band Low Speed SERDES Operation

The SERDES receiver buffers can be used to input low speed (<250Mbps: Out-Of-Band signal, OOB) by bypassing the receiver CDR and associated SERDES/PCS logic. This feature is useful for applications where the same pin is needed for both high speed and low speed data transfers down to the DC rate, as required by Serial Digital Video applications.

LatticeECP2M SERDES/PCS supports the standard definition serial digital interface, SD-SDI(143Mbps, 177Mbps, 270Mbps, 360Mbps) and the high definition serial digital interface, HD-SDI (1.485Gbps and 1.483.5Gbps).

It is required that both of these share the same receive and transmit pins. One possible implementation is shown in Figure 8-19.

The Out-Of-Band (OOB) signal port at the PCS/FPGA interface is used to input a signal slower than 250 Mbps.

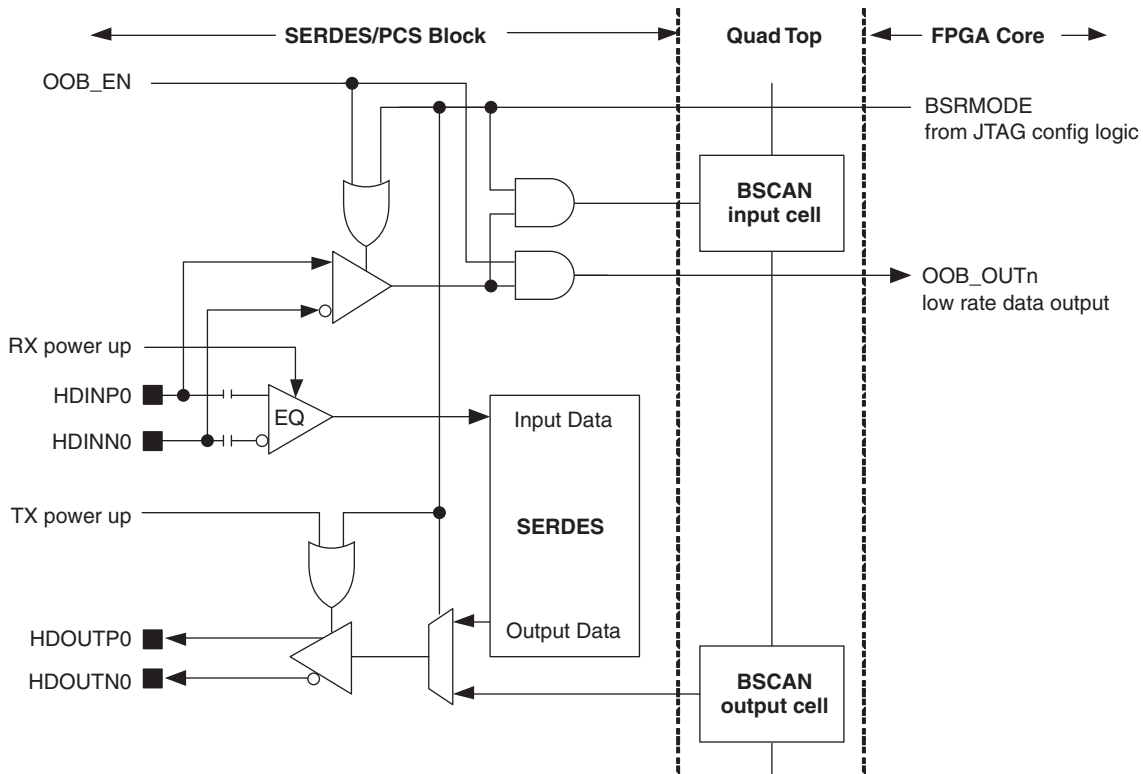
This port is available when the SD-SDI mode is selected. The OOB_OUT signal is passed directly from the SERDES input buffers to the FPGA interface and is not locked to the reference clock (see Figure 8-3).

When driving a SERDES input buffer with a low speed signal, the SERDES input buffer should be set to DC mode, which is done on a per-channel basis by selecting 'DC' in the RX I/O Coupling drop-down box of the IPexpress PCS configuration GUI (see Figure 8-25).

Though the discussion above talks about Serial Digital Video, it should be noted that similar usage is intended for any low bit rate applications that will do RX Clock Data Recovery in the FPGA logic and require decimation in the TX direction.

The input BSCAN circuit appears in parallel with the high-speed SERDES and can be used to route input data to a lower-speed Deserializer located elsewhere in the device (not in the quad). An enable signal (one per channel) is required to turn on the input BSCAN circuit independent of the BSCAN state machine.

Figure 8-19. One Possible Implementation of Serial Digital Video Support



Configuration GUIs

IPexpress is used to create and configure SERDES and PCS blocks. Designers use the graphical user interface (GUI) to select the SERDES Protocol Standard for a particular quad or channel. IPexpress takes the input from this GUI and generates a configuration file (.txt file) and HDL netlist. The HDL model is used in the simulation and synthesis flow. The configuration file contains attribute level map information. This file is input for simulation and the ispLEVER bitgen program. It is strongly recommended that designers make changes and updates in IPexpress and then regenerate the configuration file. In some exceptional occasions, users can modify the configuration file. Figure 8-20 shows the tools flow when using IPexpress to generate the SERDES/PCS block for the SERDES Protocol Standard.

When a project is saved in a different directory, this configuration file (.txt) should be manually moved to the same directory as the project file.

Figure 8-20. SERDES_PCS ispLEVER User Flow

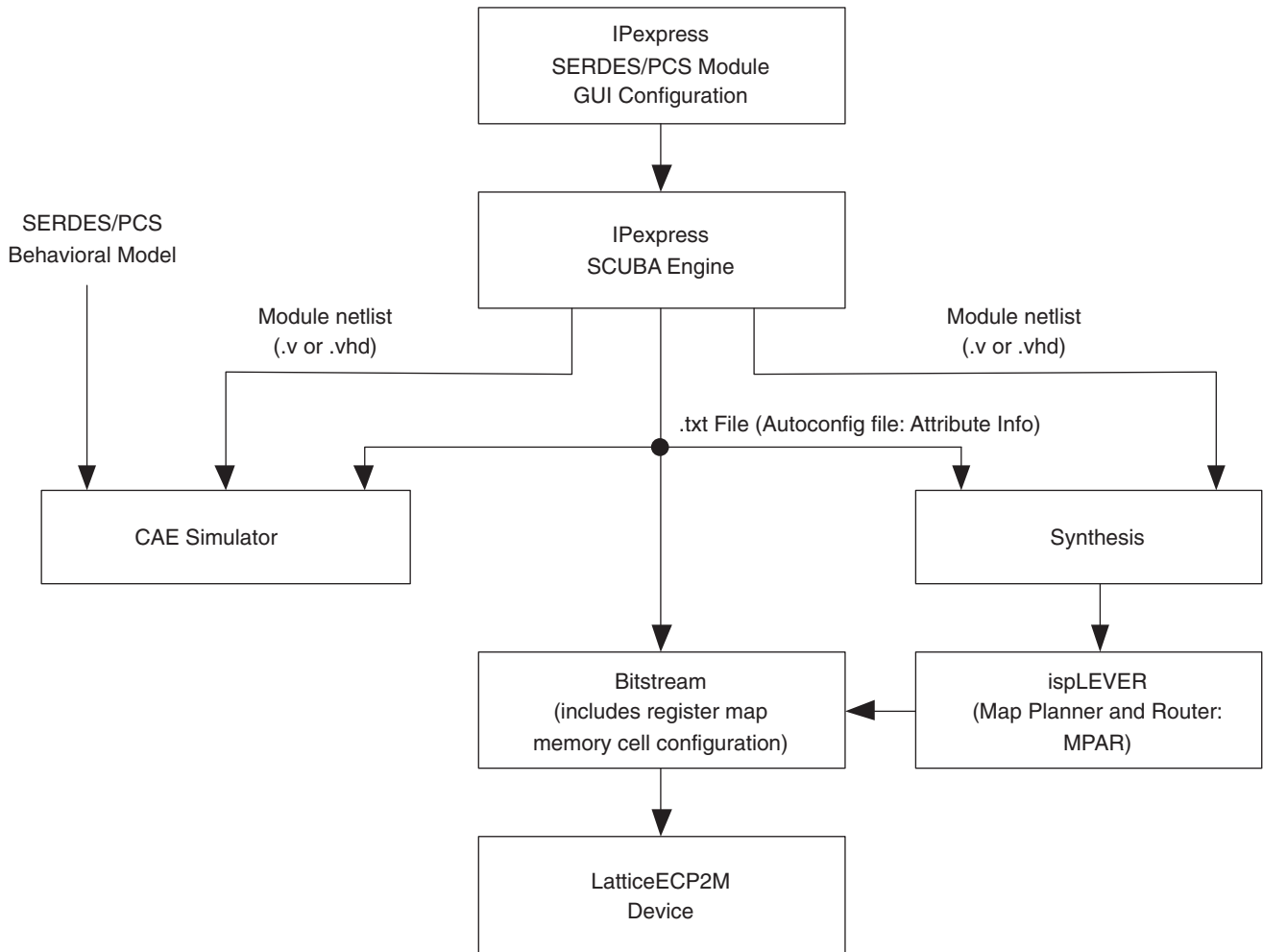
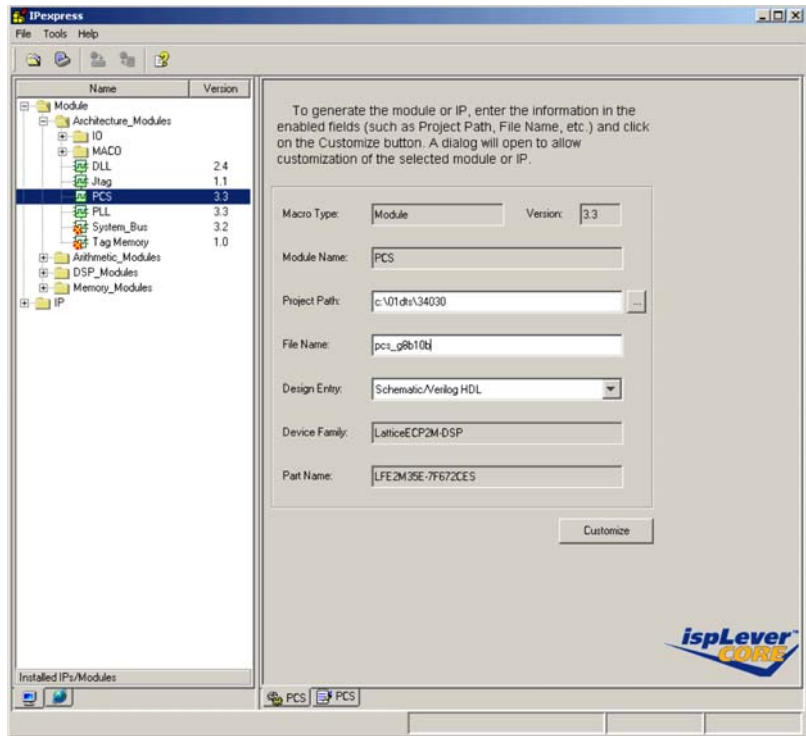


Figure 8-21 shows the main window when PCS is selected in the IPexpress GUI.

Figure 8-21. IPexpress PCS Main Window



Quad Setup Tab

Figure 8-22 shows the Quad Setup Tab window when the file name is entered and the **Customize** button is checked in the main window. The first entry required in this window is to select Protocol Mode from Quad Based Mode or Channel Based Mode. Other entries on this screen are channel selection and group selections. There are five additional tabs shown in Figures 8-23 through 8-28, listing all the user-accessible attributes with default values settings:

Figure 8-22. Configuration GUI - Quad Setup Tab

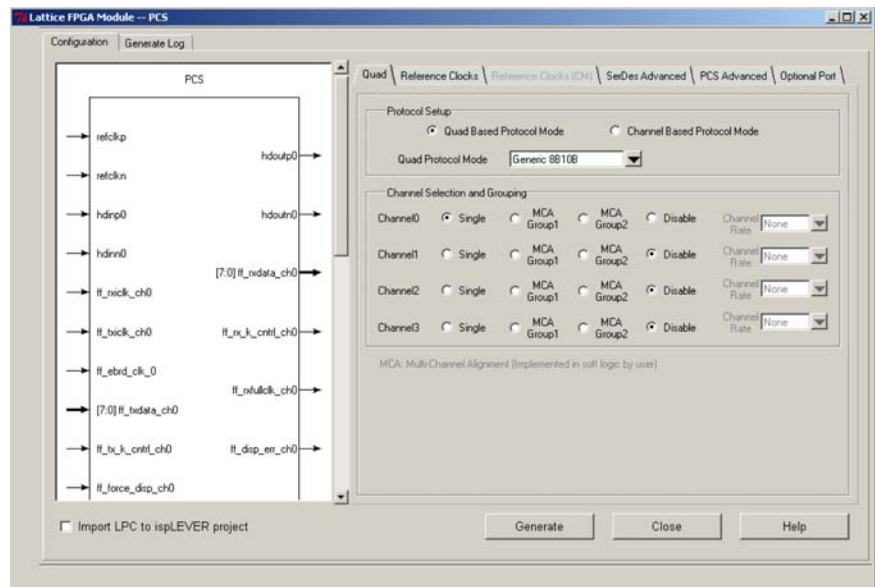


Table 8-8. SERDES_PCS GUI Attributes - Quad Tab Setup

| GUI Text | Attribute Names | Range | Default Value |
|---------------------------|-----------------|--|--------------------------|
| Protocol Setup | | Quad Based Protocol Mode, Channel Based Protocol Mode | Quad Based Protocol Mode |
| Quad Protocol Mode | PROTOCOL | PCI Express, Gigabit Ethernet, Generic 8b10b, 10-bit SERDES Only, 8-bit SERDES Only, SD-SDI, HD-SDI ² | Generic 8b10b |
| Single | CH_MODE | Enable the channel | Disable |
| MCA Group1 ³ | CH_MODE | Multi-Channel Alignment Group 1 | Disable |
| MCA Group2 ³ | CH_MODE | Multi-Channel Alignment Group 2 | Disable |
| Disable | CH_MODE | Disable the channel | Disable |
| Channel Rate ¹ | CH_MODE | Full Rate, Half Rate | Full Rate |

1. Channel Rate selection is applicable only in the Channel Based Protocol Mode.
2. Protocol Attribute Names: PCI Express = PCIE, Gigabit Ethernet = GIGE, Generic 8b10b = G8B10B, 8-bit SERDES Only = 8BSER, 10-bit SERDES Only = 10BSER, SD-SDI = SDSDI, HD-SDI = HDSDI.
3. Multi-Channel-Alignment is for transmitter lane-to-lane skew alignment. Receiver Multi-Channel-Alignment is not provided in hard PCS. MCA Group1 and MCA Group2 set the channels to CTC Bypass mode so that users can build the Multi-Channel Alignment in the FPGA core. The two groups are provided for identification of channels in Multi-Protocol applications.

Reference Clock Setup Tab

In this tab, the attributes of the Tx and Rx reference clock sources are selected. Users can select either a REFCLK or CORE_RXREFCLK as a Rx reference clock source and CORE_TXREFCLK as a Tx reference clock source for the quad. Similarly, in a quad all the channels use the same common Tx and Rx reference sources. Further, there is a tool to provide the required clock rate and multiplier settings for a particular data rate. In addition, for a given data bus width the tool provides the required clock rate to interface the quad to the core.

Figure 8-23. Configuration GUI - Reference Clocks Setup Tab

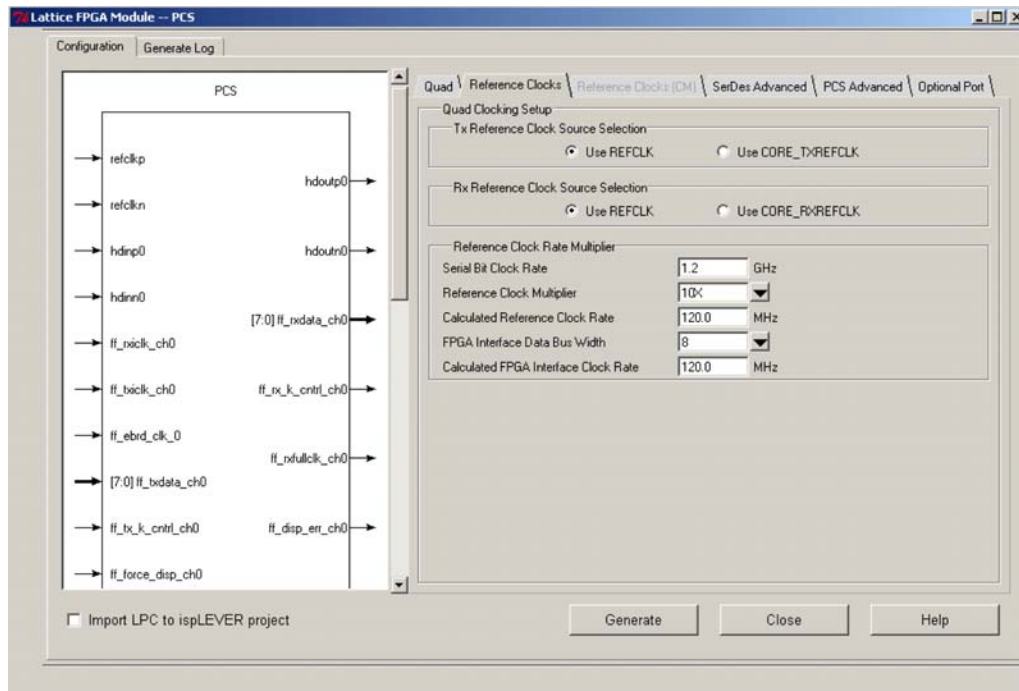


Table 8-9. SERDES_PCS GUI Attributes (LatticeECP2M) - Reference Clocks Setup Tab

| GUI Text | Attribute Names | Button/ Box Type | Range | Default Value | Comment |
|---|--|---------------------|--------------------------|---------------|--|
| Tx Reference Clock Source Selection | PLL_SRC | Radio | REFCLK, CORE_TXREFCLK | REFCLK | |
| Rx Reference Clock Source Selection | CH0_CDR_SRC CH1_CDR_SRC CH2_CDR_SRC CH3_CDR_SRC | Radio | REFCLK, CORE_RXREFCLK | REFCLK | |
| Serial Bit Clock Rate (GHz) | DATARANGE ¹ | Check Box | 0.27 to 3.125 | 2.5 | LOW: MEDLOW: MED: MEDHIGH: HIGH: |
| Reference Clock Multiplier | CH0_REFCK_MULT CH1_REFCK_MULT CH2_REFCK_MULT CH3_REFCK_MULT | Drop Down | See Table 8-10 | 25X | |
| Calculated Reference Clock Rate (MHz) ² | CP: REFCLK_RATE | Text Box | — | | Not an editable field |
| FPGA Interface Data Bus Width | CH0_DATA_WIDTH CH1_DATA_WIDTH CH2_DATA_WIDTH CH3_DATA_WIDTH | Drop Down | See Table 8-10 | 8 | |
| Calculated FPGA Interface Clock Rate (MHz) ² | CP: FPGAINCLK_RATE | Text Box | — | | Not an editable field |

1. DATARANGE:

For Production Devices: Low ≤ 500 Mbps, 500 Mbps < Medlow ≤ 1.0 Gbps, 1.0 Gbps < Med < 2.0 Gbps, 2.0 Gbps ≤ Medhigh < 2.5 Gbps, 2.5 Gbps ≤ High ≤ 3.2 Gbps

For Engineering Samples: Low ≤ 540 Mbps, 540 Mbps < Medlow ≤ 1.0 Gbps, 1.0 Gbps < Med < 2.0 Gbps, 2.0 Gbps ≤ Medhigh < 2.5 Gbps, 2.5 Gbps ≤ High ≤ 3.2 Gbps

Refer to Table 8-99 for details on the control bits setting.

2. 8-bit SERDES Only Mode and 10-bit SERDES Only Mode bypass the Link Align/Comma Align, 8b10b encoder/decoder and the CTC. It does not bypass the CDR.

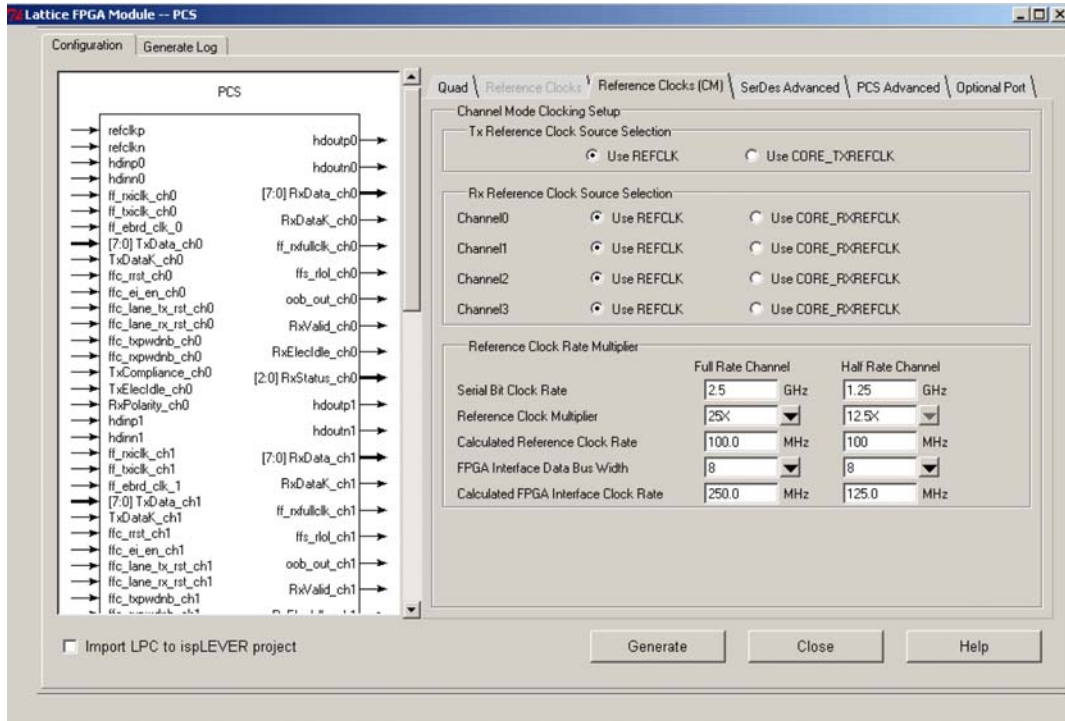
Table 8-10. Reference Clock Multiplier and FPGA Interface Data Bus Width by Protocol

| Protocol | Reference Clock Multiplier | FPGA Interface Data Bus Width |
|--------------------|----------------------------|-------------------------------|
| PCI Express | 20X, 25X | 8, 16 |
| GbE | 10XH, 10X, 20X | 8, 16 |
| G8B10B | 10XH, 10X, 20X | 8, 16 |
| 10-bit SERDES Only | 10XH, 10X, 20X | 10, 20 |
| 8-bit SERDES Only | 8HX, 8X, 16X | 8, 16 |

Reference Clock Setup Tab (Channel Mode)

In this tab, the Tx reference clock selected is common to all channels but Rx reference clocks can be either REFCLK or CORE_RXREFCLK by channel.

Figure 8-24. Configuration GUI - Reference Clocks Setup Tab (Channel Mode)



When a user selects **Channel Based Protocol Mode** in the **Quad** tab and sets a channel or channels as half rate mode, this tab displays the half rate mode clock data.

SERDES Advance Setup

This tab is used to access the advanced attributes of the transmit and receive SERDES for all four channels. Transmit attributes such as PreEmphasis, termination, differential output voltage selection are selected. Receive attributes such as equalization, termination, I/O coupling are selected. Attributes for Transmit SERDES clock and PLL are also selected.

Figure 8-25. Configuration GUI - SERDES Advanced Setup Tab

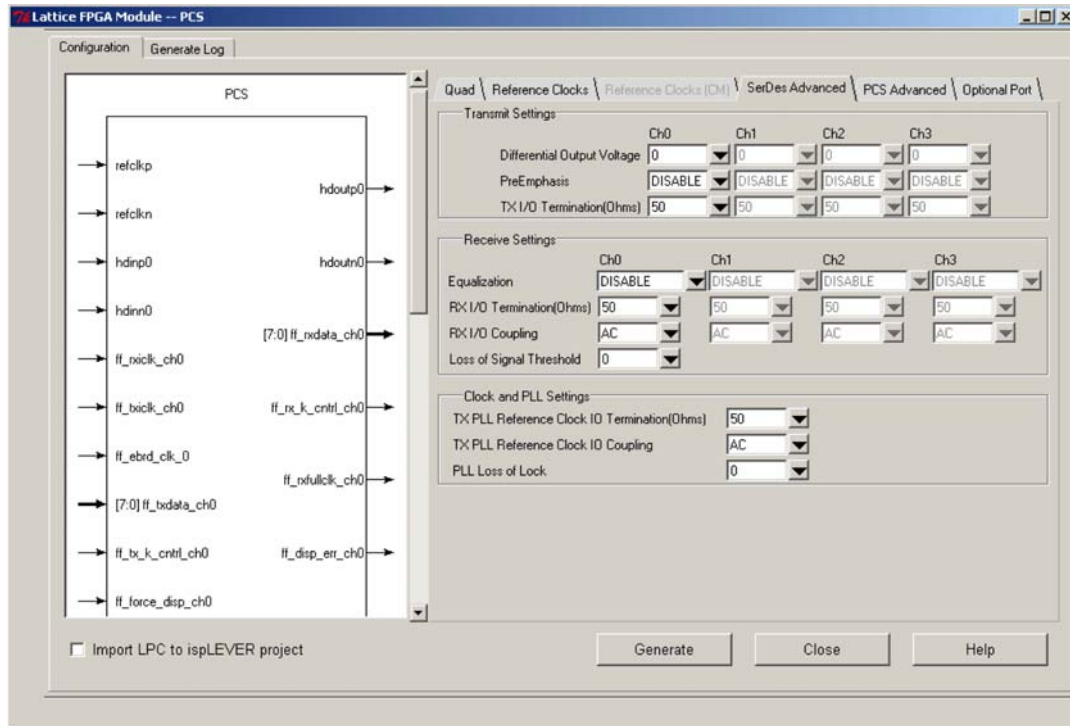


Table 8-11. SERDES_PCS GUI Attributes (LatticeECP2M) - SERDES Advanced Setup Tab

| GUI Text | | Attribute Names | Button/ Box Type | Range | | Default Value |
|--|-------------------|--|---------------------|---|--|-----------------|
| | | | | PCI Express, GIGE | G8B10B, 8bSER 10bSER | |
| Differential Output Voltage | LatticeECP2M-35 | CH0_TDRV_AMP CH1_TDRV_AMP CH2_TDRV_AMP CH3_TDRV_AMP | Drop Down | 0(1040mV: default), 1(1280mV), 2 (1320mV), 3 (1360mV), 4 (640mV), 5 (760mV), 6 (870mV), 7 (990mV) | | 0 |
| | All other devices | CH0_TDRV_AMP CH1_TDRV_AMP CH2_TDRV_AMP CH3_TDRV_AMP | | 0(990mV: default), 1(1250mV), 2 (1300mV), 3 (1350mV), 4 (610mV), 5 (730mV), 6 (820mV), 7 (940mV) | | |
| PreEmphasis | LatticeECP2M-35 | CH0_TX_PRE CH1_TX_PRE CH2_TX_PRE CH3_TX_PRE | Drop Down | Disable, 0 (0%), 1 (16%), 2 (36%), 3 (40%), 4 (44%), 5 (56%), 6 (80%) | | DISABLE |
| | All other devices | CH0_TX_PRE CH1_TX_PRE CH2_TX_PRE CH3_TX_PRE | | Disable, 0 (0%), 1 (12%), 2 (26%), 3 (30%), 4 (33%), 5 (40%), 6 (53%) | | |
| Tx I/O Termination (Ohms) ³ | | CH0_RTERM_TX CH1_RTERM_TX CH2_RTERM_TX CH3_RTERM_TX | Drop Down | 50, 75, 5K | | 50 |
| Equalization ¹ | | CH0_RX_EQ CH1_RX_EQ CH2_RX_EQ CH3_RX_EQ | Drop Down | Mid_High, Long_High Disable | Mid_Low, Mid_Med Mid_High, Long_Low Long_Med, Long_High Disable | DISABLE |
| Rx I/O Termination (Ohms) ³ | | CH0_RTERM_RX CH1_RTERM_RX CH2_RTERM_RX CH3_RTERM_RX | Drop Down | 50, 60, 75, High | | 50 |
| Rx I/O Coupling | | CH0_RX_DCC CH1_RX_DCC CH2_RX_DCC CH3_RX_DCC | Drop Down | AC, DC | | AC ² |
| Loss of Signal Threshold | | LOS_THRESHOLD | Drop Down | 0 (default), 1 (+10%), 2 (+15%),3 (+25%) 4 (-10%), 5 (-15%), 6 (-25%), 7 (-30%) | | 0 |
| Tx PLL Reference Clock I/O Termination (Ohms) ³ | | PLL_TERM | Drop Down | 50, 2K | | 50 |
| Tx PLL Reference Clock I/O Coupling | | PLL_DCC | Drop Down | AC, DC | | AC |
| PLL Loss of Lock | | PLL_LOL_SET | Drop Down | Lock | Unlock | 0 |
| | | | | 0 (+/-600ppmx) 1 (+/-300ppm) 2 (+/-1500ppm) 3 (+/-4000ppm) | 0 (+/-1200ppm) 1 (+/-2000ppm) 2 (+/-2200ppm) 3 (+/-6000ppm) | |

1. Refer to Appendix D for details.

2. The typical capacitor value of the internal on-chip AC coupling is 5 pF.

3. Termination resistors and their usage

RX I/O Termination:

50: So far all of the protocols except SMTPE use 50 Ohms termination resistor.

60: Provided for flexibility purpose only.

75: SMPTE uses 75 Ohm termination resistor.

HIGH: Such as PCI Express Rx detection.

TX I/O Termination:

50: So far all of the protocols except SMTPE use 50 Ohms termination resistor.

75: SMPTE uses 75 Ohm termination resistor.

5K: Such as PCI Express electric idle and PCI Express Rx detection.

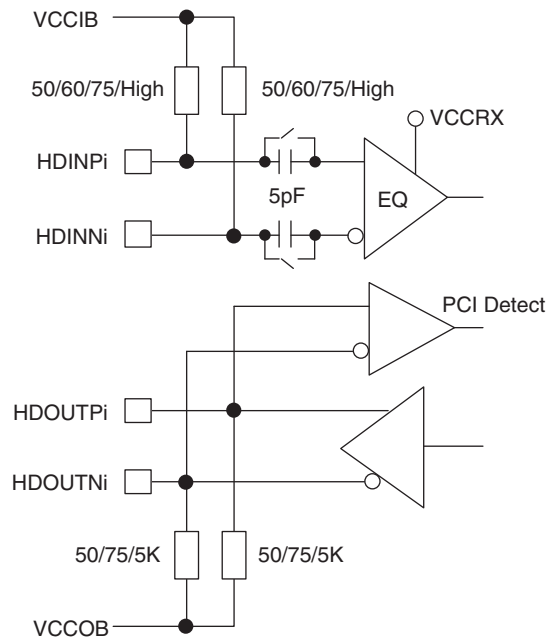
TX PLL Termination:

50: If there is no 50 Ohm termination resistor on PCB board

2K: If there is 50 Ohm termination resistor on PCB board

High speed I/O termination topology is shown in Figure 8-26.

Figure 8-26. High-Speed I/O Terminations



PCS Advanced Setup

This tab is used to access the advanced attributes of the transmit and receive PCS for all four channels. Polarity of each individual Tx and Rx channel can be individually selected. The operating mode (e.g. 8b10b) of the individual channels can be selected. In addition, word alignment values such as comma values, comma mask and comma align can be selected. This tab is also used for setting values for the Clock Tolerance Compensation block.

Figure 8-27. Configuration GUI - PCS Advanced Setup Tab

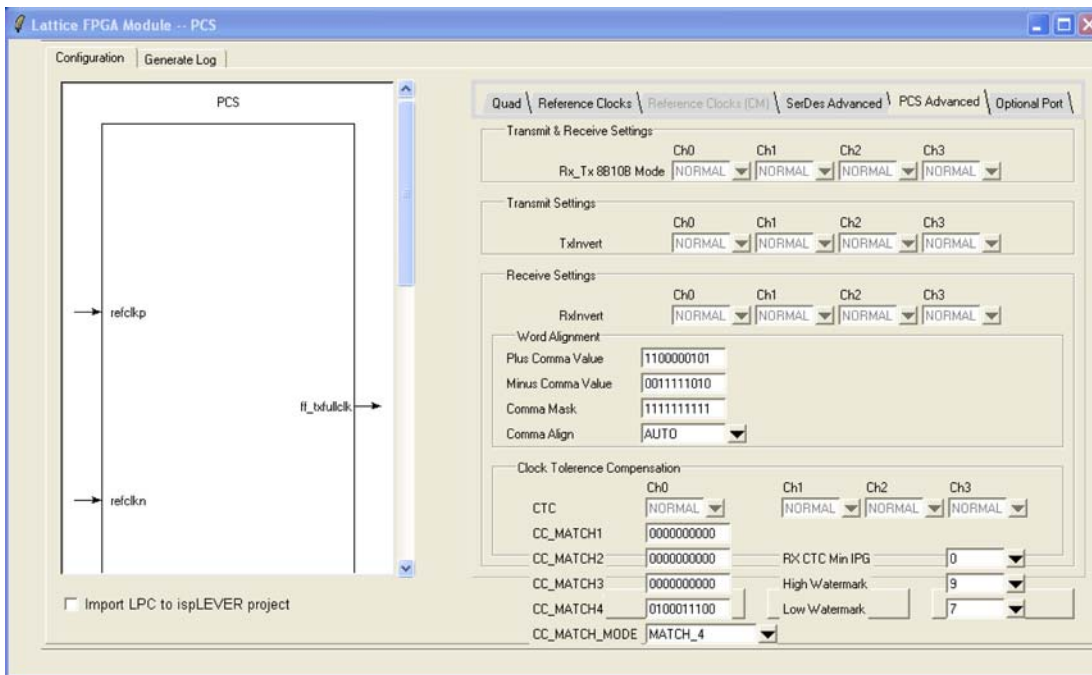


Table 8-12. SERDES/PCS GUI - PCS Advanced Setup Tab

| GUI Text | Attribute Name | 8-Bit SERDES Only | 10-Bit SERDES Only | G8B10B | PCI Express | GIGE | SD-SDI | HD-HDI | Default |
|--------------------------|----------------------|---------------------|-----------------------|---------------|-------------|--------|--------|--------|------------|
| TX Invert | CHx_TX_SB | Normal, Invert | | | | | | | Normal |
| RX Invert | CHx_RX_SB | Normal, Invert | | | | | | | Normal |
| RX_TX 8b10b Mode | CHx_8B10B | Bypass | | Normal | | Bypass | | | Normal |
| Plus Comma Value | COMMA_A ⁴ | N/A | Note 1 | | | | N/A | | 110000101 |
| Minus Comma Value | COMMA_B ⁴ | | | | | | | | 0011111010 |
| Comma Mask | COMMA_M | | | | | | | | 1111111111 |
| Comma Align ² | CHx_COMMA_ALIGN | Bypass | Auto, Dynamic, Bypass | Auto, Dynamic | Auto | | Bypass | Auto | |
| CTC ³ | CHx_CTC_BYP | Bypass ⁵ | | | Normal | | Bypass | | |
| CC_MATCH1 | CC_MATCH1 | N/A | Note 3 | | | | N/A | | 0000000000 |
| CC_MATCH2 | CC_MATCH2 | | | | | | | | 0000000000 |
| CC_MATCH3 | CC_MATCH3 | | | | | | | | 0100011100 |
| CC_MATCH4 | CC_MATCH4 | | | | | | | | 0100011100 |
| CC_MATCH_MODE | CC_MATCH_MODE | | | | | | | | MATCH_3_4 |
| RX CTC Min IFG | RX CTC Min IFG | | 0, 1, 2, 3 | | | | 0 | | |
| High Watermark | CCHMARK | | 0, 1, 2, ..., 14, 15 | | | | 9 | | |
| Low Watermark | CCLMARK | | 0, 1, 2, ..., 14, 15 | | | | 7 | | |

1. Refer to the Word Alignment section of this document for detailed information.
2. Refer to Table 8-6.
3. Refer to the Clock Tolerance Compensation section of this document for detailed information.
4. By definition, COMMA_A and COMM_B are one set of 8b10b encoded control character with positive and negative running disparities. For example, BC(K28.5) and FD(K29.7) cannot be used as the COMMA_A and COMM_B in a single design. The usage of COMMA_A and COMM_B in 8bit mode and 16bit mode is exactly the same in both modes. Users need to follow the rule in order to get the Is_sync. For example, 1 GbE needs K28.5+D5.6 or D16.2 as IDLE (word alignment and sync state machine).
5. GIGE or PCI Express modes may be used if CTC Normal mode is preferred. Note that the GIGE and PCI Express modes are tuned for their specific data rates.

Optional Setup

This tab allows is used to select the dynamic logic inversion and dynamic external link state machine capability per channel. In addition, users can enable the SCI, error reporting, PLL quarter clock, and loop-back capability.

Figure 8-28. Configuration GUI - Optional Setup Tab

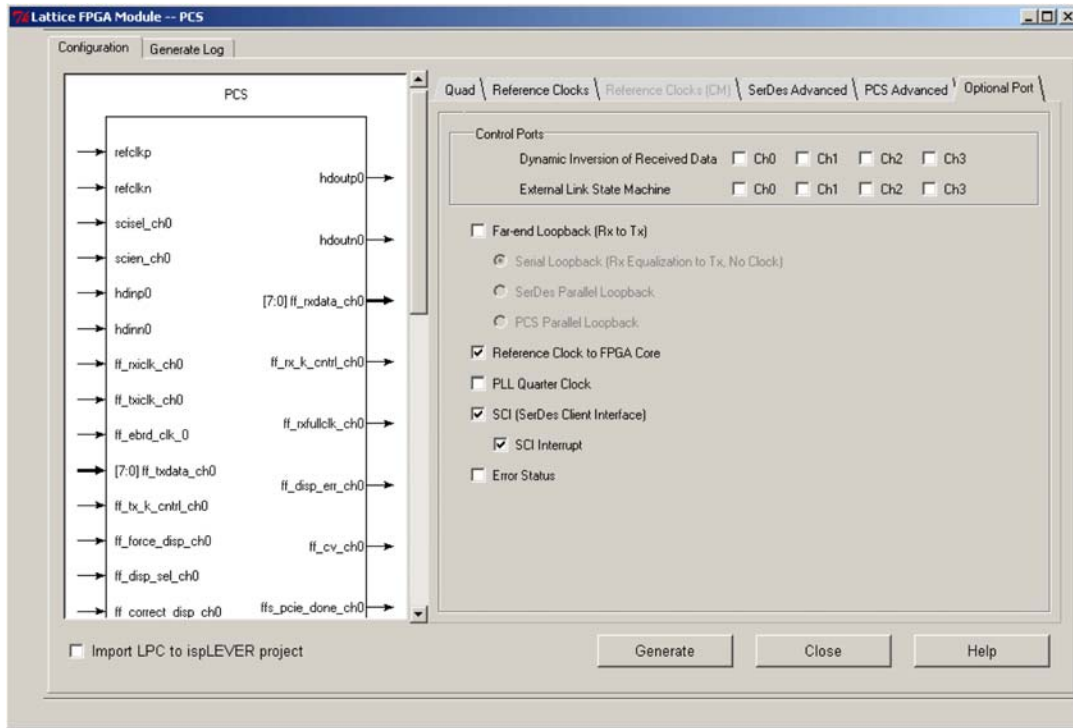


Table 8-13. Tab5. SERDES_PCS GUI Attributes (LatticeECP2M) - Optional Setup Tab

| GUI Text | Attribute Names | Button/Box Type | Range | Default Value |
|--|---|-----------------|--|-----------------|
| Dynamic Inversion of Receive Data | | Check Box | TRUE, FALSE | FALSE |
| External Link State Machine ¹ | | Check Box | TRUE, FALSE | FALSE |
| Loopback (Rx to Tx) | | Check Box | TRUE, FALSE | FALSE |
| Loopback Type | OS_SSLB OS_SPLBPORTS OS_PCSSLBPORTS | Radio Box | Serial Loopback, SERDES Parallel Loopback, PCS Parallel Loopback | Serial Loopback |
| Reference Clock to FPGA Core | OS_REFCK2CORE | Check Box | TRUE, FALSE | FALSE |
| PLL Quarter Clock | OS_PLLQCLKPORTS | Check Box | TRUE, FALSE | FALSE |
| SCI | | Check Box | TRUE, FALSE | FALSE |
| SCI Interrupt | OS_INT_ALL | Check Box | TRUE, FALSE | FALSE |
| Error Status | | Check Box | TRUE, FALSE | FALSE |

1. When Dynamic mode is selected in the Comma Align option, the External State Machine must be also selected.

Configuration File Description

IPexpress generates this file which contains attribute level map information. This file is input for simulation, synthesis and the ispLEVER bitgen program. It is strongly recommended that designers make changes in the IPexpress and then regenerate the configuration file. In some exceptional occasions, users can modify the Configuration File. The configuration file uses ".txt" as the file type extension.

Below is an example of the configuration file.

```
# This file is used by the simulation model as well as the ispLEVER bitstream
# generation process to automatically initialize the PCSC quad to the mode
# selected in the IPexpress. This file is expected to be modified by the
# end user to adjust the PCSC quad to the final design requirements.
```

```
DEVICE_NAME "LFE2M35E"
PROTOCOL    "G8B10B"
CH0_MODE    "SINGLE"
CH1_MODE    "DISABLE"
CH2_MODE    "DISABLE"
CH3_MODE    "DISABLE"
PLL_SRC     "REFCLK"
DATARANGE   "HIGH"
CH0_CDR_SRC "REFCLK"
CH0_DATA_WIDTH "8"
CH0_REFCK_MULT "10X"
#REFCLK_RATE 250.0
#FPGAINTCLK_RATE 250.0
CH0_TDRV_AMP "0"
CH0_TX_PRE   "DISABLE"
CH0_RTERM_TX "50"
CH0_RX_EQ    "DISABLE"
CH0_RTERM_RX "50"
CH0_RX_DCC   "AC"
LOS_THRESHOLD "0"
PLL_TERM     "50"
PLL_DCC      "AC"
PLL_LOL_SET  "0"
CH0_TX_SB    "NORMAL"
CH0_RX_SB    "NORMAL"
CH0_8B10B    "NORMAL"
COMMA_A      "1100000101"
COMMA_B      "0011111010"
COMMA_M      "1111111111"
CH0_COMMA_ALIGN "AUTO"
CH0_CTC_BYP  "BYPASS"
CC_MATCH1    "0000000000"
CC_MATCH2    "0000000000"
CC_MATCH3    "0100011100"
CC_MATCH4    "0100011100"
CC_MATCH_MODE "MATCH_4"
CC_MIN_IPG   "0"
CCHMARK      "4"
CCLMARK      "4"
OS_REFCK2CORE "0"
OS_PLLQCLKPORTS "0"
```

LatticeECP2M PCS in Gigabit Ethernet Mode

Gigabit Ethernet (1000BASE-X) Idle Insert

Idle pattern insertion is required for Clock Compensation and Auto Negotiation. Auto Negotiation is done in FPGA logic. This module automatically inserts /I2/ symbols into the receive data stream during auto-negotiation. While auto-negotiating, the link partner will continuously transmit /C1/ and /C2/ ordered sets. The clock-compensator will not delete these ordered sets as it is configured to only insert/delete /I2/ ordered sets. In order to prevent overruns and underruns in the clock-compensator, /I2/ ordered sets must be periodically inserted to provide insertion/deletion opportunities for the clock compensator.

While performing auto-negotiation, this module will insert a sequence of 8 /I2/ ordered sets (2 bytes each) every 2048 clock cycles. As this module is after the 8b10b decoder, this operation will not introduce any running disparity errors. These /I2/ ordered sets will not be passed on to the FPGA receive interface as the GMII interface is driven to IDLE by the Rx state machine during auto-negotiation. Once auto-negotiation is complete, /I2/ insertion is disabled to prevent any corruption of the received data.

Note that this state machine is active only during auto-negotiation. The auto-negotiation state machine and the GbE receive state machines are implemented in the soft logic. This state machine depends on the signal `ff_xmit_ch[3:0]` from the auto-negotiation state machine. This signal is provided on the TX data bus. Even though this signal is relatively static (especially after auto-negotiation) it is included in the TX data bus. It provides the signal `rx_even_ch[3:0]`. This is sent out on the receive data bus to the FPGA logic.

Gigabit Ethernet Idle Insert and `ff_correct_disp_ch[3:0]` Signal Usage

The `ff_correct_disp_ch[3:0]` signal is used on the transmit side of the QuadPCS to ensure that an inter-packet gap begins in the negative disparity state. Note that at the end of an Ethernet frame, the current disparity state of the transmitter can be either positive or negative, depending on the size and data content of the Ethernet frame. However, from the FPGA soft-logic side of the QuadPCS, the current disparity state of the QuadPCS transmitter is unknown. This is where the `ff_correct_disp_ch[3:0]` signal comes into play. If the `ff_correct_disp_ch[3:0]` signal is asserted for one clock cycle upon entering an interpacket gap, it will force the QuadPCS transmitter to insert an IDLE1 ordered-set into the transmit data stream if the current disparity is positive. However, if the current disparity is negative, then no change is made to the transmit data stream.

From the FPGA soft-logic side of the QuadPCS, the interpacket gap is typically characterized by the continuous transmission of the IDLE2 ordered set which is as follows:

```
ff_tx_k_cntrl_ch[3:0]=1, ff_txdata=0xBC    ff_tx_k_cntrl_ch[3:0]=0, ff_txdata=0x50.
```

Note that in the PCS channel, IDLE2s mean that current disparity is to be preserved. IDLE1s mean that the current disparity state should be flipped. Therefore, it is possible to ensure that the interpacket gap begins in a negative disparity state. If the disparity state before the interpacket gap is negative, then a continuous stream of IDLE2s are transmitted during the interpacket gap. If the disparity state before the interpacket gap is positive, then a single IDLE1 is transmitted followed by a continuous stream of IDLE2s.

In the FPGA soft-logic side of the QuadPCS, the interpacket gap is always driven with IDLE2s into the QuadPCS. The `ff_correct_disp_ch[3:0]` signal is asserted for one clock cycle, `k_cntrl=0`, `data=0x50` when the interpacket gap first begins. If necessary, the QuadPCS will convert this IDLE2 into an IDLE1. For the remainder of the interpacket gap, IDLE2s should be driven into the QuadPCS and the `ff_correct_disparity_chx` signal should remain deasserted.

LatticeECP2M PCS in PCI Express Mode

An LatticeECP2M quad set to PCI Express Mode in IPexpress has additional ports at the FPGA interface to enable electrical functions required by the PCI Express specification such as receiver detection. Table 8-14 describes the PCI Express Mode specific ports.

Table 8-14. PCI Express Mode Specific Ports

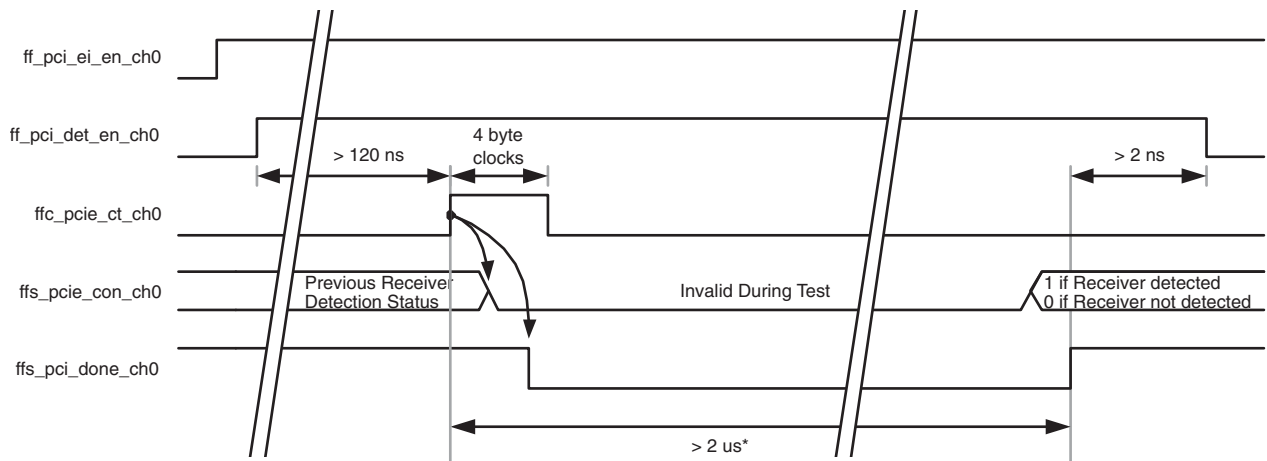
| Signal | Direction | Class | Description |
|-------------------------|-----------|---------|---|
| ffs_pcie_done_ch[3:0] | O | Channel | 1 = Far-end receiver detection complete 0 = Far-end receiver detection incomplete |
| ffs_pcie_con_ch[3:0] | O | Channel | Result of far-end receiver detection. 1 = Far end receiver detected 0 = Far end receiver not detected. |
| ffc_pcie_det_en_ch[3:0] | I | Channel | FPGA logic (user logic) informs the SERDES block that it will be requesting for a PCI Express Receiver Detection operation. 1=Enable PCI Express Receiver Detect 0 = Normal operation |
| ffc_pcie_ct_ch[3:0] | I | Channel | 1 = Request transmitter to do far-end receiver detection 0 = Normal data operation |
| ffc_ei_en_ch[3:0] | I | Channel | Control transmission of electrical idle by SERDES transmitter 1 = Force SERDES transmitter to output electrical idle 0 = Normal operation |

Receiver Detection

Figure 8-29 shows a Receiver Detection sequence. A Receiver Detection test can be performed on each channel of a quad independently. Before starting a Receiver Detection test, the transmitter must be put into electrical idle by setting the **ff_pcie_ei_en_ch** input high. The Receiver Detection test can begin 120 ns after **tx_elec_idle** is set high by driving the appropriate **ffc_pcie_det_en_ch** high. This puts the corresponding SERDES Transmit buffer into receiver detect mode by setting the driver termination to high impedance and pulling both differential outputs to VCCOB through the high impedance driver termination.

Setting the SERDES Transmit buffer into receiver detect state takes up to 120 ns. After 120ns, the receiver detect test can be initiated by driving the channel's **ffc_pcie_ct_ch** input high for four byte (word) clock cycles. The corresponding channel's **ffc_pcie_done_ch** is then cleared asynchronously. After enough time for the receiver detect test to finish has elapsed (determined by the time constant on the Transmit side), the **ffs_pcie_done_ch** receiver detect status port will go high and the Receiver Detect status can be monitored at the **ffs_pcie_con_ch** port. If at that time the **ffs_pcie_con_ch** port is high, then a receiver has been detected on that channel. If, however, the **ffs_pcie_con_ch** port is low, then no receiver has been detected for that channel. Once the Receiver Detect test is complete, **ff_pcie_ei_en_ch** can be deasserted.

Figure 8-29. PCI Express Mode Receiver Detection Sequence (Example for Channel 0)



PCI Express Beacon Support

This section highlights how the LatticeECP2M PCS can support Beacon Detection and Transmission. The PCI Express requirements for Beacon Detection are presented with the PCS support for Beacon Transmission and Beacon Detection.

- **Beacon Detection Requirements** (PCI Express Base Specification, Rev 1.0a, Chapter 4, Page 209-210)
 - Beacon is required for exit from L2 (P2) state.
 - Beacon is a DC balanced signal of periodic arbitrary data, which is required to contain some pulse widths $\geq 2\text{ns}$ (500MHz) and $< 16\mu\text{s}$ (30KHz).
 - Maximum time between pulses should be $< 16\mu\text{s}$.
 - DC balance must be restored within $< 32\mu\text{s}$.
 - For pulse widths $> 500\text{ns}$, output beacon voltage level must be 6db down from VTX-DIFFp-p (800mV to 1200mV).
 - For pulse widths $< 500\text{ns}$, output beacon voltage level must be \leq VTX-DIFFp-p and $\geq 3.5\text{db}$ down from VTX-DIFFp-p.
- **PCS Beacon Detection Support**
 - The signal loss threshold detection circuit senses if the specified voltage level exists at the receiver buffer. This is indicated by ffs_rlos_lo_ch(0-3) signal.
 - This setting can be used both for PCI Express Electrical Idle Detection and PCI Express Beacon Detection (when in power state P2).
 - The remote transmitting device can have a Beacon Output voltage of 6db down from VTX-DIFFpp (i.e 201mV). If this signal can be detected, it can be stated that Beacon is detected.
- **PCS Beacon Transmission Support**
 - Sending the K28.5 character (IDLE) (5 1's followed by 5 0's) provides a periodic pulse with of 2ns occurring every 2ns (1.0UI = 400ps, multiplied by 5 = 2ns). This meets the lower requirement. The output beacon voltage level can then be VTX-DIFFp-p. This would be valid Beacon Transmission.

PCS Loopback Modes

The LatticeECP2M family of devices provides three loopback modes controlled by control signals at the PCS/FPGA interface for convenient testing of the external SERDES/board interface and the internal PCS/FPGA logic interface. Three loopback modes are provided to loop received data back onto the transmit data path. The loopback modes are useful for checking the high speed serial SERDES package pin connections as well as the embedded SERDES and/or PCS logic.

Serial Loopback Mode

Loops serial receive clock/data back onto the transmit buffer without passing through the CDR or de-serializer. This feature is intended for internal testing purpose but users can also use it.

Selecting the Serial Loopback option in the IPexpress GUI will set only the LB_CTL[3:0] to '0010' (refer to Table 8-77).

The TDRV_DAT_SEL[1:0] register bits should be also set to '11' via SCI to enable Serial Loopback mode. The LB_CTL[3:0] register bits are also accessible via SCI.

SERDES Parallel Loopback Mode

Loops parallel receive data back onto the transmit data path without passing through the PCS logic. SERDES parallel loopback can be selected for each channel individually by setting the appropriate ffc_sb_pfifo_lp_ch(0-3) to a "1".

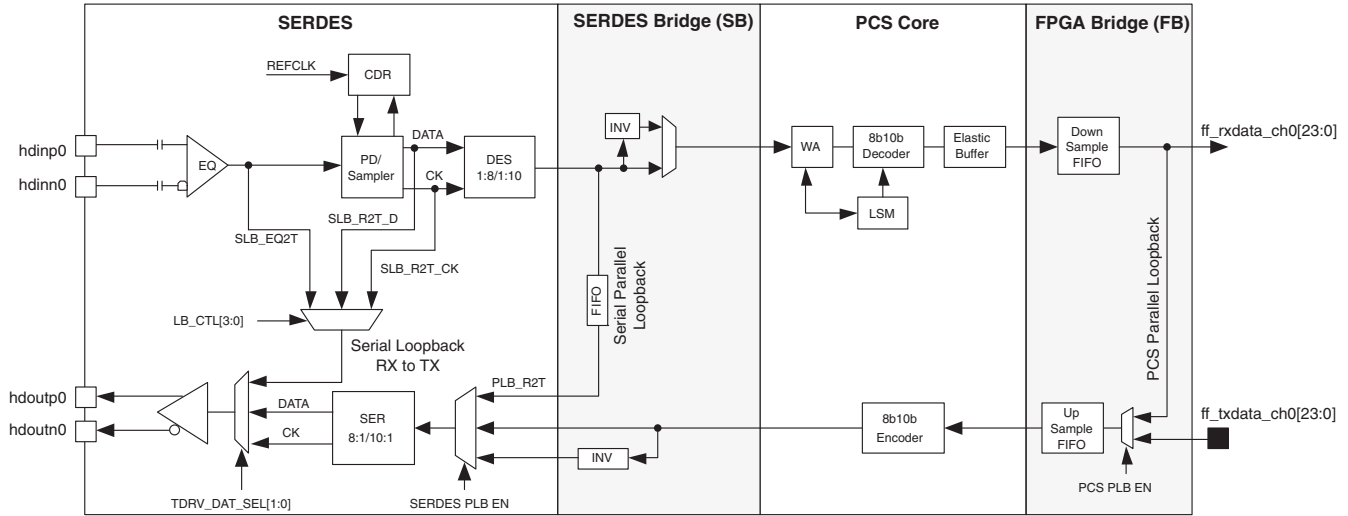
PCS Parallel Loopback Mode

Loops parallel receive data back onto the transmit data path without passing across the PCS/FPGA interface. Input serial data at the SERDES hdin package pins passes through the SERDES receive logic where it is converted to

parallel data, passes through the entire PCS receive logic path, is looped back through the entire PCS transmit logic path, is reconverted back to serial data by the SERDES transmitter and sent out onto the hdout SERDES package pins. PCS Parallel loopback can be selected for each channel individually by setting the appropriate ffc_fb_loopback_ch(0-3) port to a “1”.

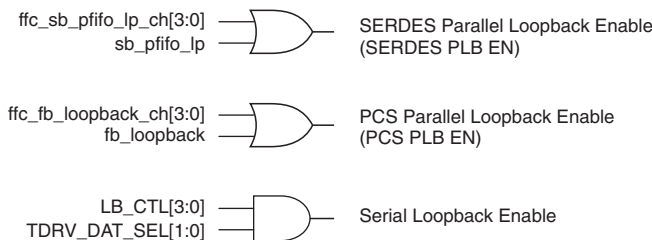
Figure 8-30 illustrates the three loopback modes for a single channel.

Figure 8-30. Three Loopback Modes



The two parallel loopback modes described above provide not only control signals from the FPGA core but also Control Register bits. When the control register bits are not set for the loopback mode, the data path can switch between Loopback mode and Normal Data Flow by control signals from the FPGA core. Figure 8-31 describes this logic. Refer to Tables 8-77 and 8-78 for detailed register settings.

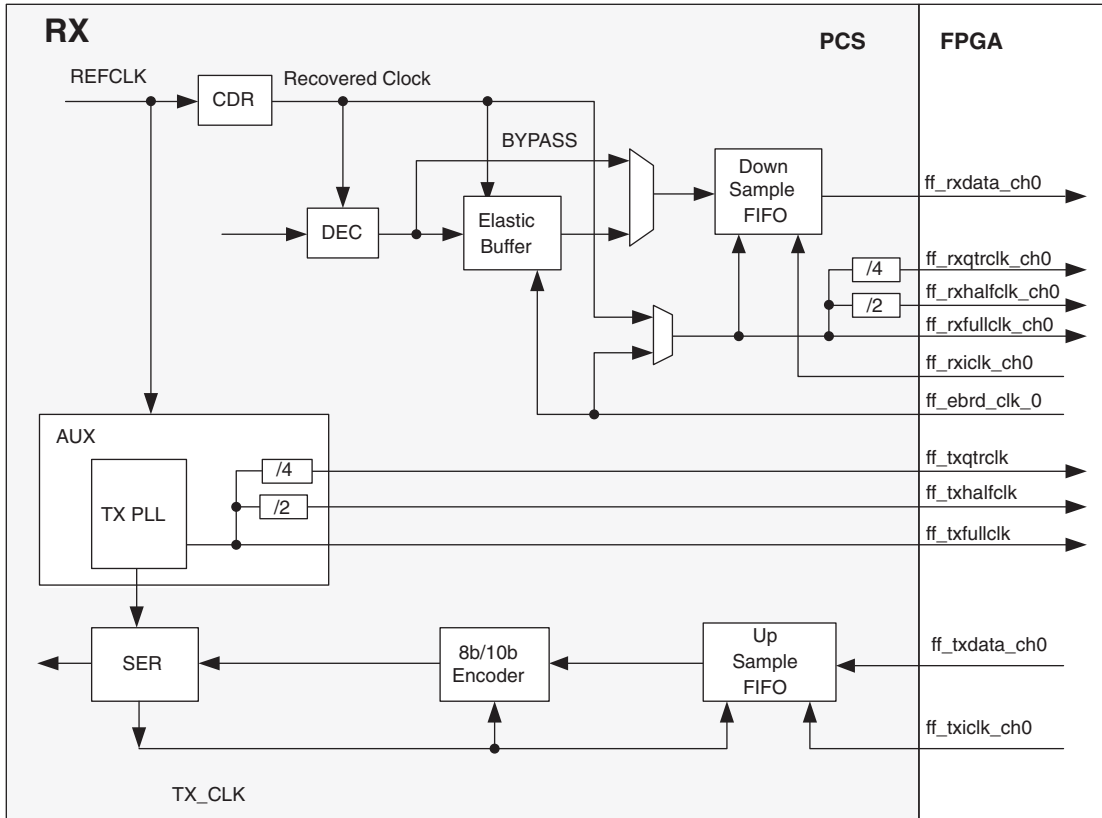
Figure 8-31. Loopback Enable Signals



FPGA Interface Clocks Usage

Figure 8-32 shows a conceptual diagram of the later stage of the PCS Core and the FPGA Bridge and the major clocks that cross the boundary between PCS and the FPGA.

Figure 8-32. Conceptual PCS/FPGA Clock Interface Diagram



In the above diagram and in the subsequent clock diagrams in this section, note that suffix “i” indicates the index [0:3] i.e., one for each channel.

None of the clock muxes have logic to guard against clock slicing or glitching. It is a requirement that if any of the selectors to the clock muxes are changed by writes to register bits, the software agent will reset the logic clocked by that muxed clock.

The PCS outputs 15 clocks. There are three transmit clocks (per quad) and 12 receive clocks (per channel). The three transmit clocks provide full rate, half rate and quarter rate clocks and are all generated from the Tx PLL. The full rate and half rate transmit clocks need to be send directly via dedicated route to the Center Clock Mux in the FPGA. There are also three clocks (full, half and quarter rates) per receive channel. All 15 clocks can be used as local (secondary) or global (primary) clocks for the FPGA logic as required. Divided-by-two clocks are used when the gearing is in 2:1 mode (the gearing is selectable only on a quad basis).

The transmit clock is used on the write port of the Up Sample FIFO (or Phase Shift FIFO, depending on the case). One of the two receive clocks is connected to the read clock of the Down Sample FIFO. The other clocks the read port of the Elastic Buffer FIFO and potentially (depending on the case) the write port of the Down Sample FIFO.

Based on the whether the Elastic Buffer and the Up Sample FIFO are bypassed or not and whether we are in 8b10b mode or 16b20b mode, four use cases are possible. The active paths are highlighted with weighted lines. It is also indicated how many and what kind of clock trees are required. There are some modes that would more commonly be preferred by the user.

This section describes the operation for the six different cases that are supported. The six cases are outlined in Table 8-15.

Table 8-15. Six Interface Cases Between SERDES/PCS Quad and FPGA Core

| Interface | Data Width | Rx CTC FIFO | Rx Phase-Shift/Down-Sample FIFO | Tx Phase-Shift/Up-Sample FIFO |
|------------------------|------------|-------------|---------------------------------|-------------------------------|
| Case I-a ¹ | 8b10b | Yes | Yes | Yes |
| Case I-b ¹ | 8b10b | Bypass | Yes | Yes |
| Case II-a ¹ | 16b20b | Yes | Yes | Yes |
| Case II-b ¹ | 16b20b | Bypass | Yes | Yes |

1. In all cases in which the Tx phase-shift (up-sample) FIFO is used, it is never bypassed. Deep inside the SERDES/PCS block, the datapath width is 8/10 bits wide and the byte clock runs at 1/10 of the SERDES line rate. For example, if the SERDES line rate is 3.125Gbps, then the byte clock is 312.5MHz.

2-to-1 Gearing

For guaranteed performance of the FPGA global clock tree, it is recommended to use a 16/20 bit wide interface for SERDES line rates greater than 2.5Gbps. In this interface, the FPGA interface clocks are running at half the byte clock frequency.

Even though the 16/20 bit wide interface running at half the byte clock frequency can be used with all SERDES line rates, the 8/10 bit wide interface is preferred when the SERDES line rate is low enough to allow it (2.5Gbps and below) because this results in the most efficient implementation of IP in the FPGA core.

The decision matrix for the six interface cases is explained in Table 8-16.

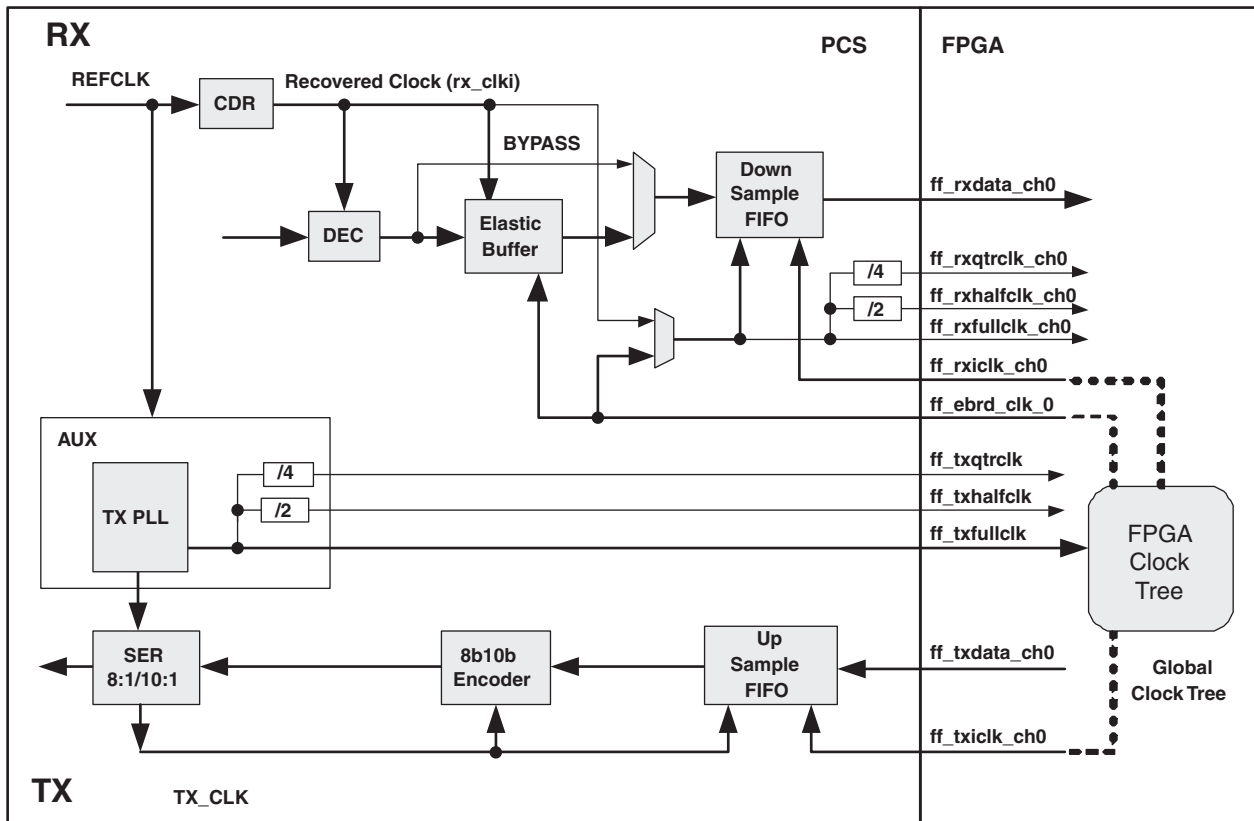
Table 8-16. Decision Matrix for Six Interface Cases

| SERDES Line Rate | Datapath Width | MCA Required? | CTC Required? | Interface Case |
|--------------------|-------------------------|-------------------------|----------------------------|------------------------|
| 2.5 Gbps and below | 8/10 bit (1:1 gearing) | No, single-channel link | Yes | Case I_a ¹ |
| | | | No | Case I_b ² |
| | | Yes, multi-channel link | Must bypass, not available | Case I_b ³ |
| 3.2 Gbps and below | 16/20 bit (2:1 gearing) | No, single-channel link | Yes | Case II_a ⁴ |
| | | | No | Case II_b ⁵ |
| | | Yes, multi-channel link | Must bypass, not available | Case II_b ⁶ |

1. This case is intended for SINGLE-channel links at line rates of 2.5Gbps and lower (8/10 bit wide interface) that require clock tolerance compensation in the quad. CTC is required when both ends of the link have separate reference clock sources that are within +/- 300ppm of each other. Case I_a is used if the IP in the core requires the Rx phase-shift FIFO. Case I_b is used if the IP does not require this FIFO.
2. This case is intended for SINGLE-channel links at line rates of 2.5Gbps and lower (8/10 bit wide interface) that do NOT require clock tolerance compensation in the quad. CTC is not required when both ends of the link are connected to the same reference clock source. This is often the case for chip-to-chip links on the same circuit board. There is exactly 0ppm difference between the reference clocks and so CTC is not required and can be bypassed. CTC is also not required in the quad when this function is performed by the IP in the core.
3. This case is intended for MULTI-channel links at line rates of 2.5Gbps and lower (8/10 bit wide interface). Multi-channel alignment MUST be done by the IP in the core, there is no provision to do MCA in the quad. Since MCA must be done prior to CTC, the CTC FIFO in the quad MUST be bypassed when MCA is required and so both MCA and CTC (if required) are done by the IP in the core.
4. This case is intended for SINGLE-channel links at line rates of 3.2Gbps and lower that require a 2:1 gearbox between the quad and the FPGA core (16/20 bit wide interface). Clock tolerance compensation is included in the quad. CTC is required when both ends of the link have separate reference clock sources that are within +/- 300ppm of each other.
5. This case is intended for SINGLE-channel links at line rates of 3.2Gbps and lower that require a 2:1 gearbox between the quad and the FPGA core (16/20 bit wide interface). Clock tolerance compensation is NOT included in the quad. CTC is not required when both ends of the link are connected to the same reference clock source. This is often the case for chip-to-chip links on the same circuit board. There is exactly 0ppm difference between the reference clocks and so CTC is not required and can be bypassed. CTC is also not required in the quad when this function is performed by the IP in the core.
6. This case is intended for MULTI-channel links at line rates of 3.2Gbps and lower that require a 2:1 gearbox between the quad and the FPGA core (16/20 bit wide interface). Multi-channel alignment MUST be done by the IP in the core, there is no provision to do MCA in the quad. Since MCA must be done prior to CTC, the CTC FIFO in the quad MUST be bypassed when MCA is required and so both MCA and CTC (if required) are done by the IP in the core.

Case I_a: 8/10bit, EB and DS FIFOs NOT Bypassed

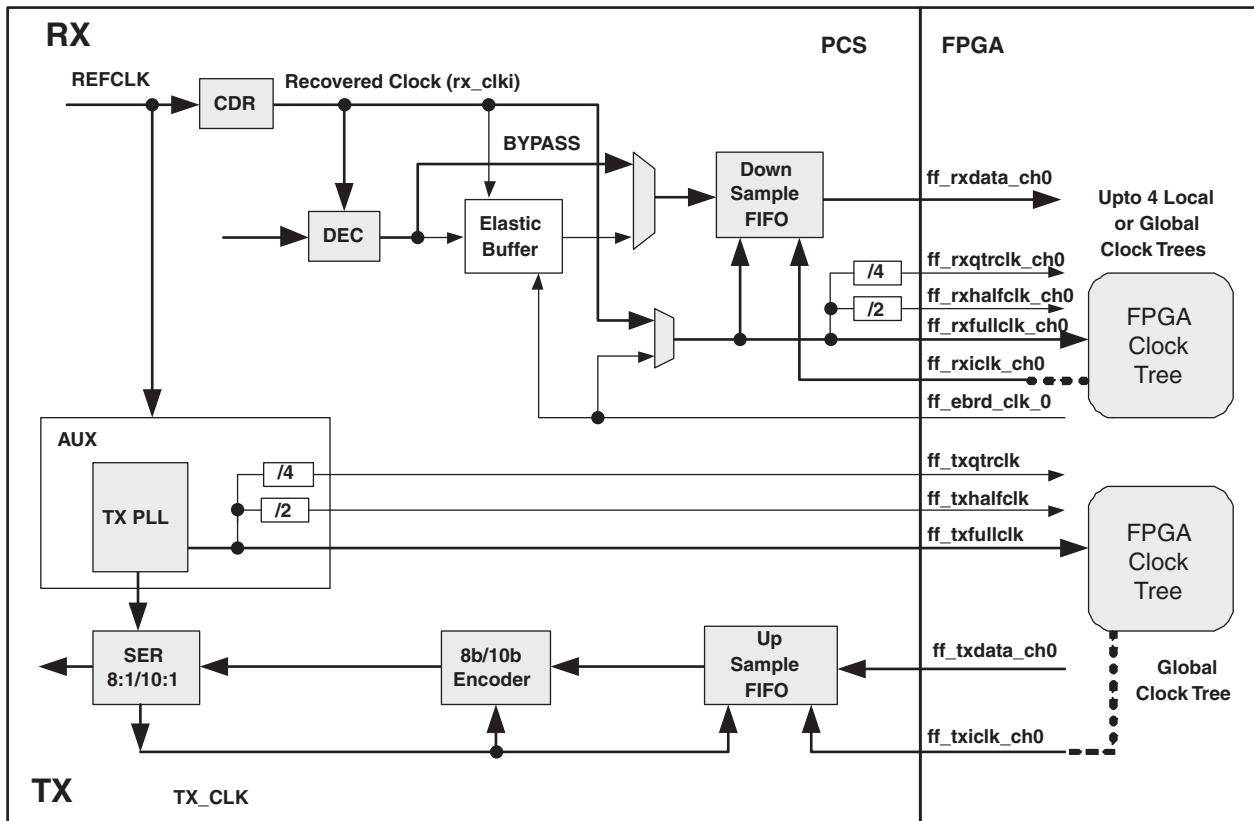
Figure 8-33. 8b10b, EB and DS FIFOs NOT Bypassed



1. The Up Sample FIFO is acting as a Phase Shift FIFO only in this case.
2. The Down Sample FIFO is acting as a Phase Shift FIFO only in this case.
3. The quad level full rate clock from the Tx PLL (ff_tx_f_clk) has direct access to the FPGA Center Clock Mux. This is a relatively higher performance path. A Global Clock Tree out of the Center Clock Mux is used to clock the user's interface logic in the FPGA. Some leaf nodes of the clock tree are connected to the FPGA Transmit Input clock (ff_txi_clki), the Elastic Buffer FIFO Read Clock per Channel (ff_ebrd_clki) via CIB Clk input and the FPGA Receive Input clock (ff_rxi_clki). This case is probably the most common single channel use case.

Case I_b: 8/10bit, EB FIFO Bypassed

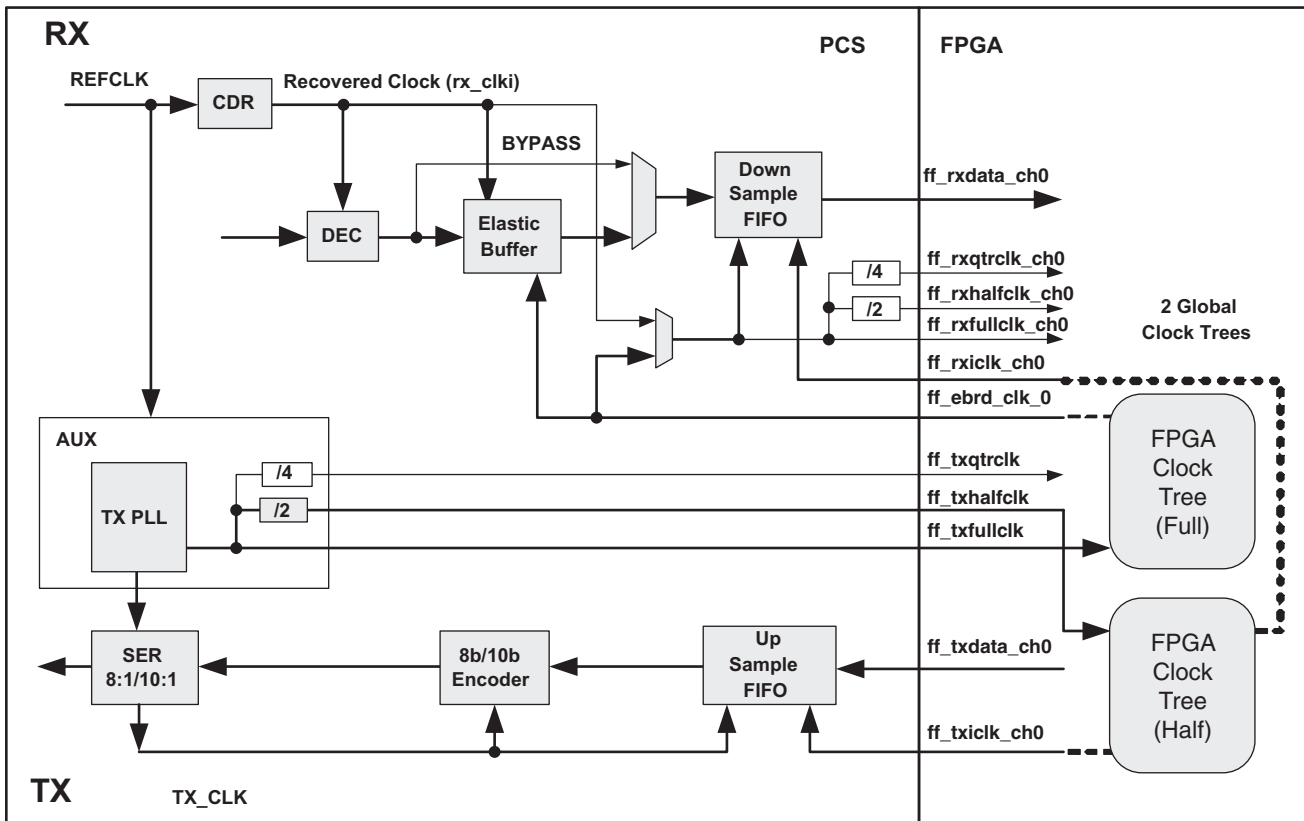
Figure 8-34. 8b10b, EB FIFO Bypassed



1. The Up Sample FIFO is acting as a Phase Shift FIFO only in this case.
2. The Down Sample FIFO is acting as a Phase Shift FIFO only in this case.
3. The Tx FPGA Channel input clock is clocked similarly as in the previous case using a clock tree driven by a direct connection of the full rate transmit FPGA output clock to the FPGA center clock mux. Once the Elastic Buffer is bypassed, the recovered clock needs to control the write port of the Down Sample FIFO. The recovered clock of each channel may need to drive a separate local or global clock tree (i.e., up to 4 local or global clock trees per quad). The clock tree will then drive the FPGA receive clock input to control the read port of the Down Sample FIFO. The reason for bypassing the Elastic Buffer FIFO in this case is most likely for doing multi-channel alignment (MCA) in the FPGA core. It implies that CTC using an elastic buffer will be done in the FPGA core. The CTC FIFOs can be written by either the recovered clocks or by a master recovered clock. The read of the CTC FIFO will be done using the Tx clock via the Tx clock tree.

Case II_a: 16/20bit, EB and DS FIFOs NOT Bypassed

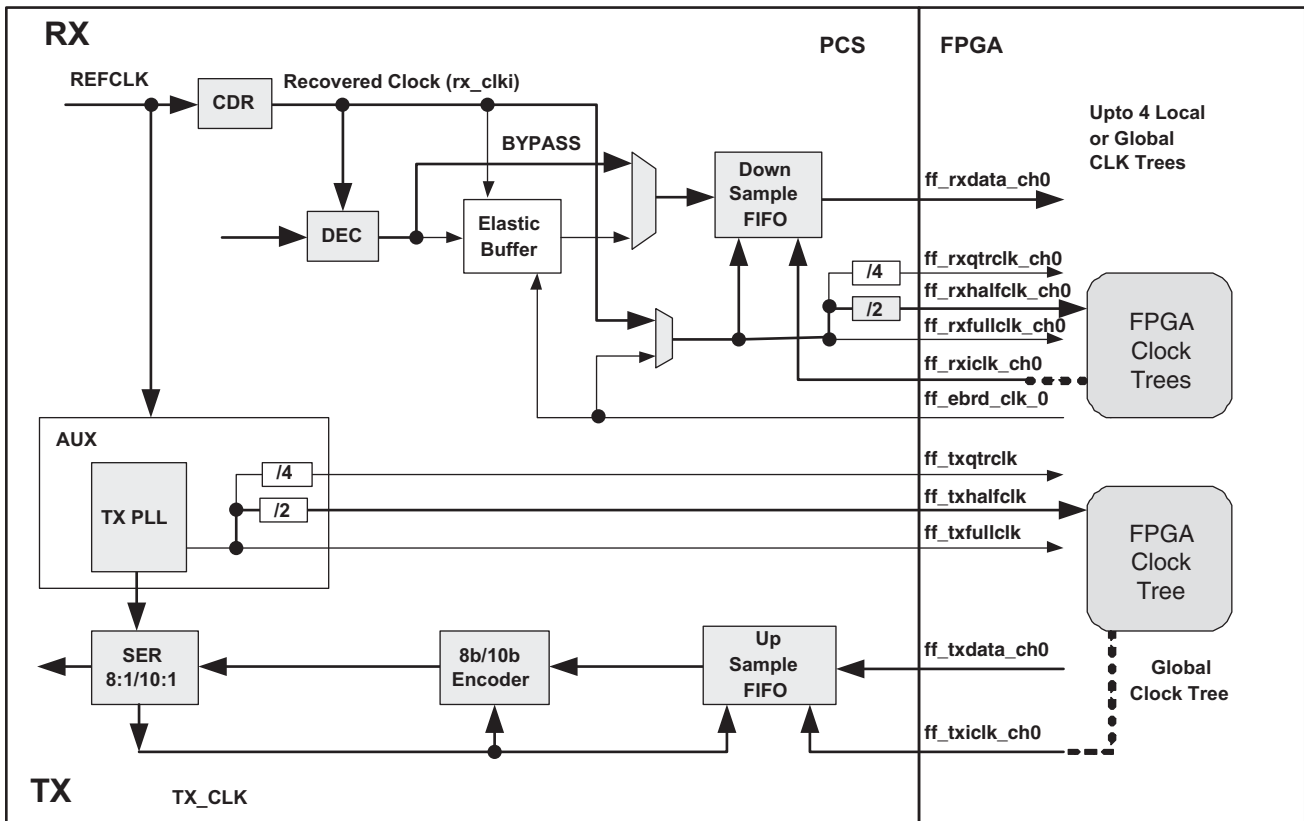
Figure 8-35. 16/20bit, EB and DS FIFOs NOT Bypassed



1. The Up Sample FIFO is acting both as a Phase Shift FIFO and Up Sample FIFO in this case.
2. The Down Sample FIFO is acting both as a Phase Shift FIFO and Down Sample FIFO in this case.
3. This is a very common single channel use case when the FPGA is unable to keep up with full byte frequency. Two clock trees are required. These clock trees are driven by direct access of transmit full rate clock and transmit half rate clock to the FPGA clock center mux. The full rate clock tree drives the Elastic Buffer read port and the Down Sample FIFO write port. The half rate clock tree drives the Down Sample FIFO and the FPGA logic.

Case II_b: 16/20bit, DS NOT Bypassed

Figure 8-36. 16/20 Bit, DS FIFO NOT Bypassed



1. The Up Sample FIFO is acting both as a Phase Shift FIFO and Up Sample FIFO in this case.
2. The Down Sample FIFO is acting both as a Phase Shift FIFO and Down Sample FIFO in this case.
3. This is a very common multi-channel alignment (MCA) use case when the FPGA is unable to keep up with full byte frequency. The receive clock trees (up to 4) can be local or global. They are running half rate clock. The transmit clock tree is driven by direct access of transmit half rate clock to the FPGA clock center mux. In this case, in FPGA logic after the MCA is done, a CTC will be required. The Tx clock tree will clock the read port of the CTC and the master channel receive clock the write port of the CTC. It is important to note that both the MCA and CTC need to be done across 16/20bits in this use case.

SERDES/PCS Block Latency

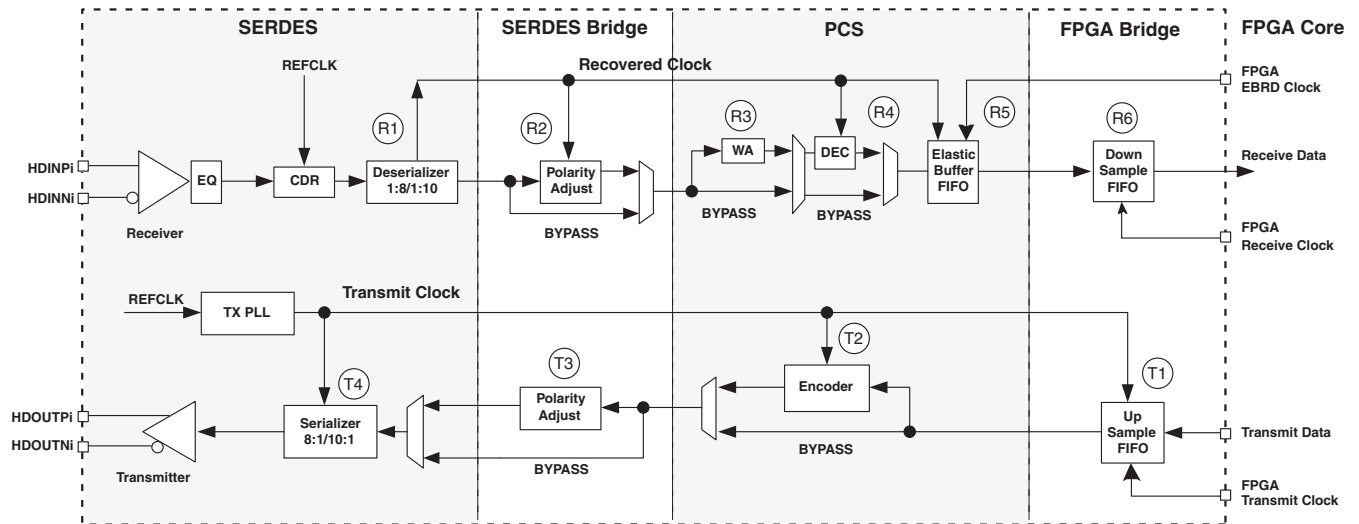
Table 8-17 describes the latency of each functional block in the transmitter and receiver. Latency is given in parallel clock cycles. Figure 8-37 shows the location of each block.

Table 8-17. SERDES/PCS Latency Breakdown (Parallel Clock Cycle)¹

| Item | Description | Min. | Average | Max. | Fixed | Bypass | Units |
|------------------------------|-----------------------------------|------|---------|------|---------|--------|----------|
| Transmit Data Latency | | | | | | | |
| T1 | FPGA Bridge Transmit ² | 1 | 3 | 5 | | 1 | word clk |
| T2 | 8b10b Encoder | — | — | — | 2 | 1 | word clk |
| T3 | SERDES Bridge Transmit | — | — | — | 2 | 1 | word clk |
| T4 ³ | Serializer: 8-bit mode | — | — | — | 15 + Δ1 | — | UI + ps |
| | Serializer: 10-bit mode | — | — | — | 18 + Δ1 | — | UI + ps |
| Receive Data Latency | | | | | | | |
| R1 ³ | Deserializer: 8-bit mode | — | — | — | 10 + Δ2 | — | UI + ps |
| | Deserializer: 10-bit mode | — | — | — | 12 + Δ2 | — | UI + ps |
| R2 | SERDES Bridge Receive | — | — | — | 2 | 1 | word clk |
| R3 | Word Alignment | 3.1 | — | 4 | — | 0 | word clk |
| R4 | 8b10b Decoder | — | — | — | 1 | 1 | word clk |
| R5 | Clock Tolerance Compensation | 7 | 15 | 23 | | 1 | word clk |
| R6 | FPGA Bridge Receive ² | 1 | 3 | 5 | | 1 | word clk |

1. PCS internal Parallel Clock. This clock rate is same as the rxfullclk in Table 8-5.
2. FPGA Bridge latency varies by UP/DOWN Sample FIFO read/write. These numbers were presented for 8bit/10bit interface. The depth of Down Sample/Up Sample FIFO is 4. The earliest read can be done after write clock cycle (1 clock) in Down Sample FIFO. The latest read will be done after the FIFO is full (4 + 1 = 5). For 16b/20b interface, the numbers become doubled. Min = 2, Max = 10. This latency depends on the internal FIFO flag operation.
3. Δ1 = -245ps, Δ2 = 700ps

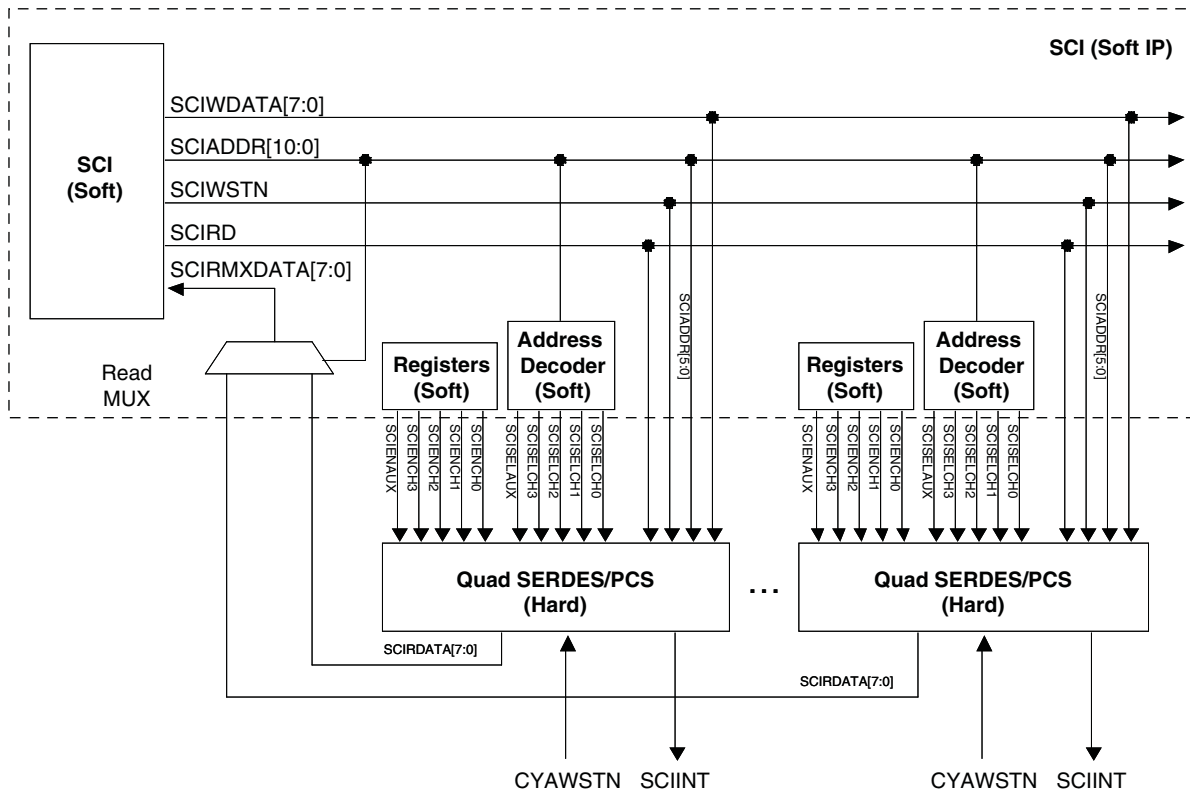
Figure 8-37. Transmitter and Receiver Block Diagram



SERDES Client Interface (SCI)

The SERDES Client Interface (SCI) consists of both soft IP that resides in the FPGA core and permanent logic that is included in the SERDES/PCS quad. The SCI allows the SERDES/PCS quad to be controlled by registers as opposed to the configuration memory cells. It is a simple register configuration interface. It shows all the major signals required. The block diagram of the soft IP part of the SCI that resides in the FPGA core is shown in Figure 8-38.

Figure 8-38. SCI Interface Block Diagram



The soft IP that resides in the FPGA core should be developed by users per their interface scheme. Contact the Lattice Technical Support Group for example code.

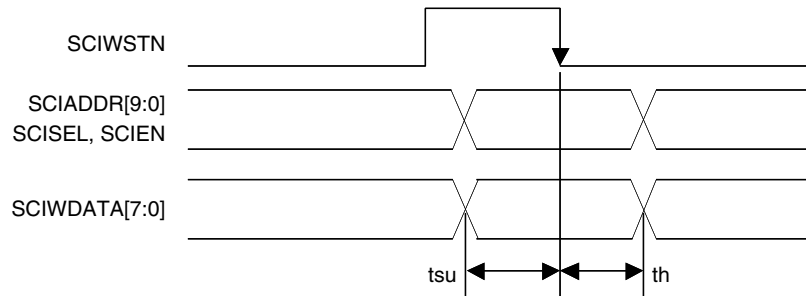
The SCIADDR bus is six bits wide within the block. The bus width at the block boundary is 11 bits. The upper five bits are used for quad block selection and channel selection. Table 8-18 shows the SCI address map for the SERDES quad.

Table 8-18. SCI Address Map for Up to Four SERDES/PCS Quads

| Address Bits | Description |
|---------------|--|
| SCIADDR[5:0] | Register address bits 000000 = select register 0 000001 = select register 1 ... 111110 = select register 62 111111 = select register 63 |
| SCIADDR[8:6] | Channel address bits 000 = select channel 0 001 = select channel 1 010 = select channel 2 011 = select channel 3 100 = select aux channel 101 = unused 110 = unused 111 = unused |
| SCIADDR[10:9] | Quad address bits 00 = select quad 0 01 = select quad 1 10 = select quad 2 11 = select quad 3 |

Read and write operations through this interface are asynchronous. In the WRITE cycle the Write data and Write address need to be setup and held in relation to the falling edge of the SCIWSTN. In the READ cycle the timing has to be in relation with the SCIRD pulse. Figures 8-39 and 8-40 shows the WRITE and READ cycles respectively.

Figure 8-39. SCI WRITE Cycle, Critical Timing

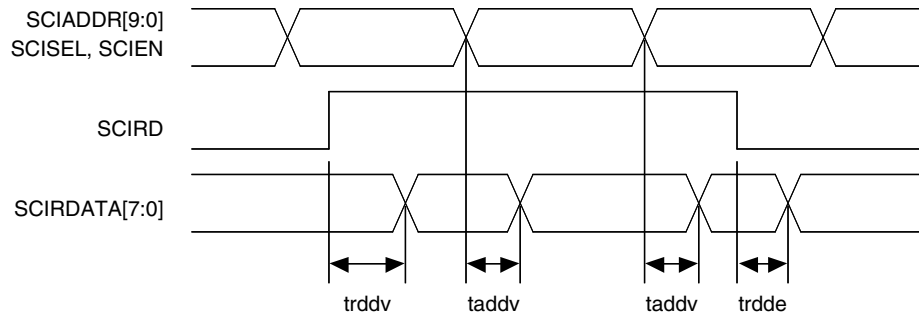


Notes :

- 1) tsu is the setup time for address and write data prior to the falling edge of the write strobe.
- 2) th is the hold time for address and write data after the falling edge of the write strobe.

Note: To avoid accidental writing to control registers, registers should be used at the SCI input ports to drive them low at power-up reset.

Figure 8-40. SCI READ Cycle, Critical Timing



- Notes:
- 1) trddv is the time from assertion of the read pulse until read data is valid.
 - 2) taddv is the time from address change until data is valid while read pulse is asserted.
 - 3) trdde is the hold time of the read data after the deassertion of the read pulse.

Table 8-19. Timing Parameters

| Parameter | Typical Value | Units |
|-------------------|---------------|-------|
| tsu, trddv, taddv | 1.127 | ns |
| th, trdde | 0.805 | ns |

The SCI interface is as simple as memory read/write. Here is an example of the pseudo code:

Write

```
Cycle 1 : Set sciaddr[5:0], sciwdata[7:0], scien* = 1'b1 scisel* = 1'b1
Cycle 2 : Set sciwstn from 0 => 1
Cycle 3 : Set sciwstn from 1 => 0, scien* = 1'b0, scisel* = 1'b0
```

Read

```
Cycle 1 : Set sciaddr[5:0], scisel* = 1'b1
Cycle 2 : Set scird from 0 => 1
Cycle 3 : Obtain reading data from scirdata[7:0]
Cycle 4 : Set scird from 1 => 0
```

Interrupts and Status

The status bit may be read via the SCI, which is a byte wide and thus reads the status of eight interrupt status signals at a time. The SCIINT signal goes high to indicate that an interrupt event has occurred. The user is then required to read the QIF status register that indicates whether the interrupt came from the quad or one of the channels. This register is NOT cleared-on-read. It is cleared when all interrupt sources from the quad or channel is cleared.

Once the aggregated source of interrupt is determined, the user can read the registers in the associated quad or channel to determine the actual source of the interrupt. Tables 8-20 and 8-21 list all the sources of interrupt.

Table 8-20. Quad Interrupt Sources

| Quad SCI_INT Source | Description | Register Name |
|---|--|-------------------------------|
| int_quad_out | Quad Interrupt. If there is an interrupt event anywhere in the quad this register bit will be active. This register bit gets cleared when all interrupt events have been cleared. | PCS Quad Status Register 1 |
| int_cha_out[0:3] | Channel Interrupt. If there is an interrupt event anywhere in the respective channel this register bit will be active. These register bits are cleared when all interrupt sources in the respective channel have been cleared. | PCS Quad Status Register 1 |
| ls_sync_statusn_[0:3]_int ls_sync_status_[0:3]_int | Link Status Low (out of sync) channel interrupt Link Status High (in sync) channel interrupt | PCS Quad Status Register 3 |
| ~PLOL, PLOL | Interrupt generated on ~PLOL and PLOL - PLL Loss of Lock | SERDES Quad Status Register 2 |

Table 8-21. Channel Interrupt Sources

| Quad SCI_INT Source | Description | Register Name |
|---|---|---|
| fb_tx_fifo_error_int fb_rx_fifo_error_int cc_overrun_int cc_underrun_int | FPGA Bridge Up Sample Tx FIFO Error Interrupt FPGA Bridge Down Sample Rx FIFO Error Interrupt CTC (Elastic Buffer) Overrun and Underrun Interrupts | PCS Channel General Interrupt Status Register 4 |
| pci_det_done_int rlos_lo_int ~rlos_lo_int rlos_hi_int ~rlos_hi_int rlol_int ~rlol_int | Interrupt generated for pci_det_done Interrupt generated for rlos_lo Interrupt generated for ~rlos_lo Interrupt generated for rlos_hi Interrupt generated for ~rlos_hi Interrupt generated for rlol Interrupt generated for ~rlol | SERDES Channel Interrupt Status Register 5 |

SERDES Client Interface Application Example

Lattice Semiconductor's ORCAstra FPGA configuration software is a PC-based Graphical User Interface (GUI) that allows users to configure the operational mode of a Lattice FPGA by programming control bits in the FPGA registers. SERDES/PCS status information is displayed on-screen in real time, and any configuration can be saved to control registers for additional testing. Use of the GUI does not interfere with the programming of the FPGA core portion. More information and downloadable files for ORCAstra can be found on the Lattice Semiconductor website at www.latticesemi.com/products/designsoftware/orcastra.cfm.

For example:

Users can switch the reference clock multiplier mode between 10x mode and 20x mode by changing refck_mode[1](D7) and refck_mode[0](D6) bits in the Quad PCS Control Register, ser_ctl_3_qd_13. The SCI address of the register is 13(H) and ORCAstra Address = 113 (H). The Quad Reset (QD_18[5]) must be toggled to achieve this transition.

The read/write operation can be achieved in two different ways.

1. In the main window, users can read and write the content of control register read status registers.
2. In the sub-windows, users can select pull-down menu options, or check/uncheck ON/OFF options.

Table 8-22. SCI Address Map

| Address Bit | Description |
|---------------|--|
| SCIADDR[5:0] | Register address bits 000000 = register 0 000001 = register 1 111110 = register 62 111111 = register 63 |
| SCIADDR[8:6] | Channel address bits 000 = channel 0 001 = channel 1 010 = channel 2 011 = channel 3 100 = Aux channel |
| SCIADDR[10:9] | Quad address bits 00 = quad 0 01 = quad 1 10 = quad 2 11 = quad 3 |

Dynamic Configuration of SERDES/PCS Quad

The SERDES/PCS quad can be controlled either by the configuration memory cells or by registers that are accessed through the optional “SERDES Client Interface” (SCI). The SCI consists of both a soft IP that resides in the FPGA core and permanent logic that is included in the SERDES/PCS quad. The SCI is only available if the soft IP is present in the FPGA core.

After configuration is complete, those configuration memory cells that have associated registers are automatically copied into the registers. Subsequent changes to the contents of the registers will not affect the value stored in the configuration memory cells but will of course change the operation of the SERDES/PCS quad.

When controlled by the configuration memory cells, it is a requirement that the SERDES/PCS quads must reach a functional state after configuration is complete, without further intervention from the user. This means that any special reset sequences that are required to initialize the SERDES/PCS quad must be handled automatically by the hardware. In other words, use of the SCI is optional, the SERDES/PCS quad must NOT assume that the soft IP is present in the FPGA core.

SERDES Debug Capabilities

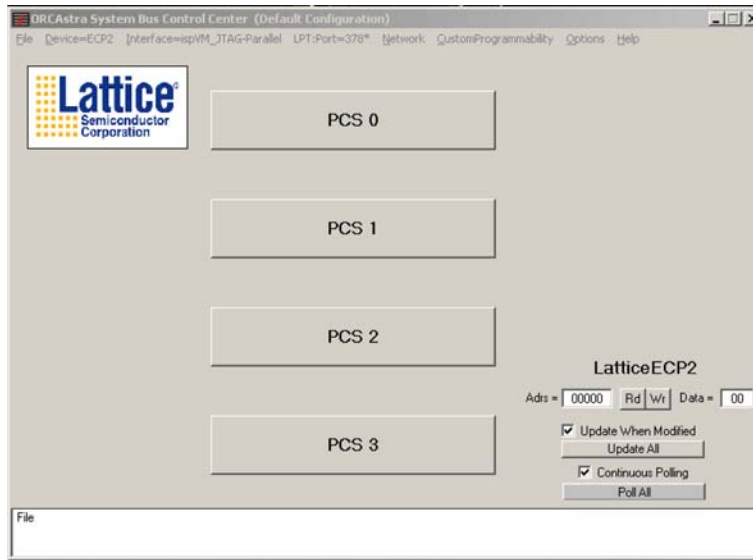
Lattice has tools to help in the debug of the SERDES/PCS operation in LatticeECP2M devices.

Lattice ORCAstra software is a PC-based graphical user interface for configuring the operational mode of a LatticeECP2M device by programming control bits in the on-chip registers. This helps you quickly explore configuration options without going through a lengthy re-compile process or making changes to your board. Configurations created in the GUI can be saved to memory and re-loaded for later use. To use ORCAstra, SCI IP must be instantiated in the user logic.

A macro capability is also available to support script-based configuration and testing. The GUI can also be used to display system status information in real time. Use of the ORCAstra software does not interfere with the programming of the FPGA.

Figure 8-41 shows the ORCAstra GUI top-level window. Users can read and write in this window without going through the subwindows for each PCS channel by read and write data at Adrs cell. When invoked, ORCAstra will automatically recognize the device type. Or, device types can be selected under the device pull-down menu.

Figure 8-41. ORCAstra Top-Level Screen Shot

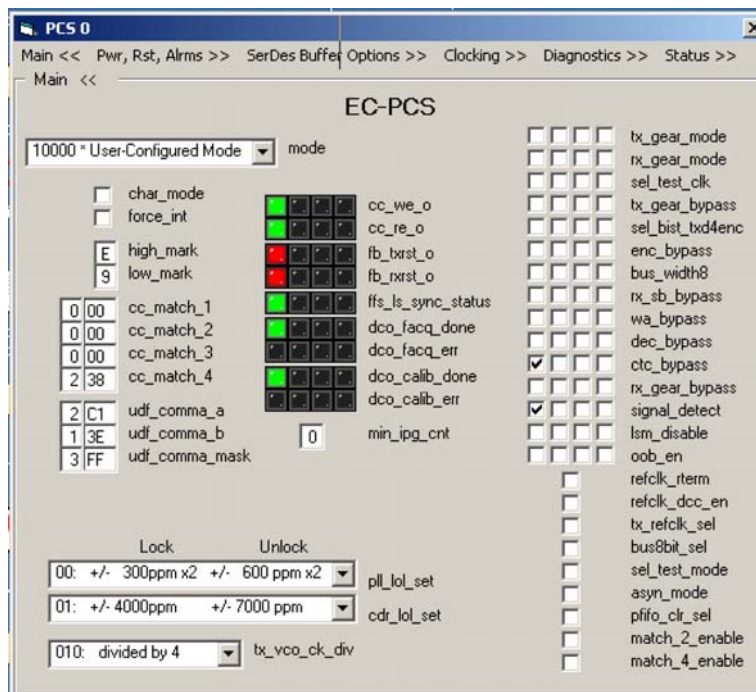


By default, the Data Box shown in Figure 8-41 follows Little Endian byte order (i.e., the most significant bit is placed on the right). Users can change to Big Endian order by selecting **Display Data reversed in Data Box** under the **Options** tab.

Double clicking on the **PCS0 (Quad 0)** button will open the main window as shown in Figure 8-42.

These standard Windows menus control the selection of the device and interface. They also support various configuration options, including setting up and saving configurations with stored files.

Figure 8-42. ORCAstra Main Window

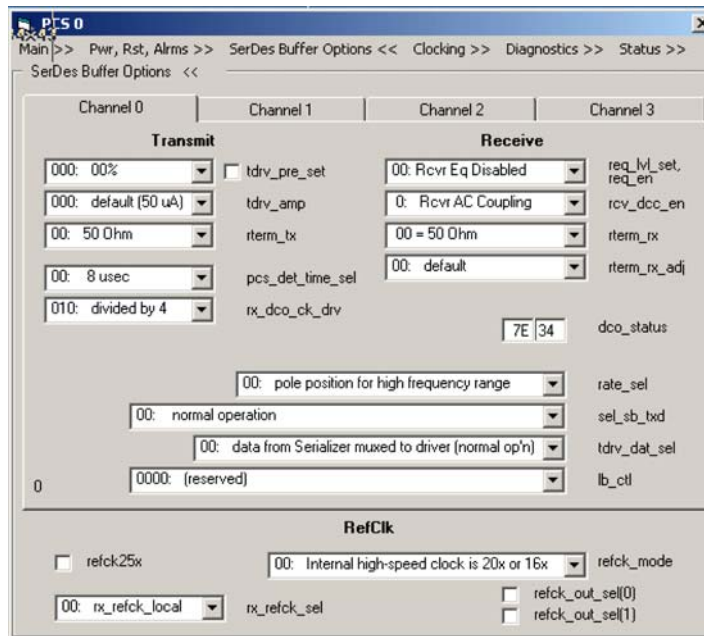


Control Boxes and Buttons, Status Boxes and the Text Window

Moving the cursor over a control box and clicking the left mouse button sets the control bits. Both the bit location and function for the selected box are displayed in the text window and will match those of the register map tables in the device's data sheet. Only the function is displayed when the cursor is over the bit name. Status boxes are similar to control boxes but have an LED appearance and a colored background.

Figure 8-43 shows SERDES Buffer Options window. Configuration options can be selected from the pull-down menu.

Figure 8-43. SERDES Buffer Options Window



More information and downloadable files for ORCAstra can be found on the Lattice Semiconductor website at the following address: www.latticesemi.com/products/designsoftware/orcastra.cfm.

Other Design Considerations

LatticeECP2M-35 vs. All Other LatticeECP2M Devices

Important Note: The SERDES settings (in the .txt file) for the LatticeECP2M-35 are different from all other LatticeECP2M devices. The difference includes default settings that are hidden in the .txt file. When there is device migration from LatticeECP2M-35 to all other LatticeECP2M devices, users must re-generate the PCS module from the IPexpress GUI.

Engineering Samples vs. Production Devices

Engineering samples and production devices have their own simulation models and libraries. The library name for the engineering sample is pcsc_mti_work_revA.

Simulation of the SERDES/PCS

SERDES/PCS simulation support is provided by a pre-compiled model for ModelSim® and NC-Verilog®. The simulation model that is pre-compiled is a behavioral model for the SERDES and the RTL of the PCS. Table 8-23 provides the location for each of the simulation models.

Table 8-23. Simulation Model Locations

| Simulator | Model Location |
|--|--|
| Cadence NC-Verilog/VHDL, NC-Sim, Synposys VCS, Mentor Graphics ModelSim, Aldec Riviera Pro | ispTools\cae_library\simulation\blackbox |

Note: Model file names with “revA” are for LatticeECP2M-35 engineering samples only.

Models that are distributed in .zip files need to be decompressed before the model can be used.

Reset Usage in Simulation

If any of the PCS reset signals is not tied to GND, the designer must be careful if the same reset signal is used in the FPGA core. For example, if one of the reset signals is used to reset both the PCS and a counter in the FPGA core, and the counter uses txfullclk, the counter will not work. The counter cannot reset itself because txfullclk is not running when the reset is active.

Depending on the reference clock sources, the reset assertion time can vary.

For simulation only, it is recommended to use a minimum active duration of 100ns for PCS reset signals.

16/20-bit Word Alignment

The PCS receiver can not recognize the 16-bit word boundary. With COMMA_ALIGN in 'AUTO' mode, the PCS can only do BYTE alignment. The 16-bit word alignment should be done in the FPGA fabric and is fairly straight forward. The simulation model works in the same way. It can be enhanced if users implement an alignment scheme as described below.

For example, if transmit data before at the FPGA interface are:

YZABCDEFGH IJKLM... (each letter is a byte, 8-bit or 10-bit)

Then the incoming data in PCS after 8b10b decoder and before rx_gearbox are:

YZABCDEFGH IJKLM....

After rx_gearbox, they can become:

1. {ZY}{BA}{DC}{FE}{HG}{JI}{LK}....

or

2. {AZ}{CB}{ED}{GF}{IH}{KJ}{ML}...

Clearly sequence 2 is not aligned. It has one byte offset, but 16/20-bit alignment is needed. Let’s say the special character 'A' should be always placed in the lower byte.

Flopping one 20-bit data combines with the current 16/20-bit data to form 32/40-bit data as shown below:

1. {DCBA}{HGFE}{LKJI}....

^
| **Found the A in lower 10-bit, set the offset to '0', send out aligned data 'BA'

Next clock cycle:

{FEDC}{JIHG}{NMLK}....

^
| **send out aligned data 'DC'

etc.

After the 16/20-bit alignment, the output data are:

{ZY}{BA}{DC}{FE}{HG}{JI}{LK}....

2. {CBAZ}{GFED}{KJIH}....

 | **Found the A in upper 10-bit, set the offset to '10', send out aligned data 'BA'

Next clock cycle:

{EDCB}{IHGF}{MLKJ}....

 | **send out aligned data 'DC'
etc.

After the 20-bit alignment, the output data are:

{ZY}{BA}{DC}{FE}{HG}{JI}{LK}....

Note: The LSB of a 8/10-bit byte or a 16/20-bit word is always transmitted first and received first.

Switching Between 10XH, 10X and 20X Reference Clock Multiplier Modes Using SCI

Designers can change the bit rates between 10XH, 10X and 20X reference clock multiplier modes using the SERDES Client Interface. This is a useful feature in a system where different rates are received at times and the receiver is able to sweep between different rates and lock to one of them. For example, a system can sweep three different rates of 622Mbps, 1.244Gbps and 2.488Gbps and lock to one of them whichever is received.

There are a few control register bits associated with different rates.

```
CH_0A[D1]: rate_mode_tx
CH_0B[D1]: rate_mode_rx
QD_13[D6]: refclk_mode[0]
QD_18[D5]: quad_rst
```

Switching Between 20X to 20XH or 10X to 10XH Mode in 16-Bit Interface

In addition to the control register settings described above, the transmit interface clock(ff_txiclck_chn) input must be switched from txhalfclk to txqtrclk as described in Table 8-5. ff_rxiclck_chn is not affected in this case. The CDR PLL will automatically tune to the incoming data rate and provide the correct rxhalfclk as described in Table 8-5.

Contact the Lattice Semiconductor Technical Support Group for detailed information.

Off-Chip AC Coupling

When off-chip AC coupling is required, the recommended capacitor values are shown in Table 8-24.

Table 8-24. Off-chip AC Coupling Capacitor Values

| Protocol | Min. | Typ. | Max. | Remark | Units |
|--------------------|------|------|------|-------------|-------|
| 8b10b | 4.7 | 10 | | @ 3.125Gbps | nF |
| PCI Express rev1.1 | 75 | | 200 | | nF |

When a DC balanced pattern is used, such as 8b10b encoding, a capacitor of minimum 4.7nF, is required to reduce the edge degradation.

Data patterns with longer run lengths require larger capacitance values to reduce pattern dependent jitter.

Refer to Lattice technical note TN1114, [Electrical Recommendations for Lattice SERDES](#), for more information.

Unused Quad/Channel and Power Supply

On unused channels, VCCTX, VCCR_X, VCCP and VCCAUX33 should be powered up. VCCIB, VCCOB, HDINP/N, HDOUTP/N and REFCLKP/N should be left floating. Unused channel outputs are tristated, with approximately 10 KOhm internal resistor connecting between the differential output pair.

VCCAUX33 supplies power to termination resistors. It is recommended to have the PI filter like the other power supplies. VCCAUX33 noise will directly be coupled to high-speed I/O, HDIN/HDOUT. If VCCAUX(FPGA core power supply) is very clean, it can be connected to VCCAUX33.

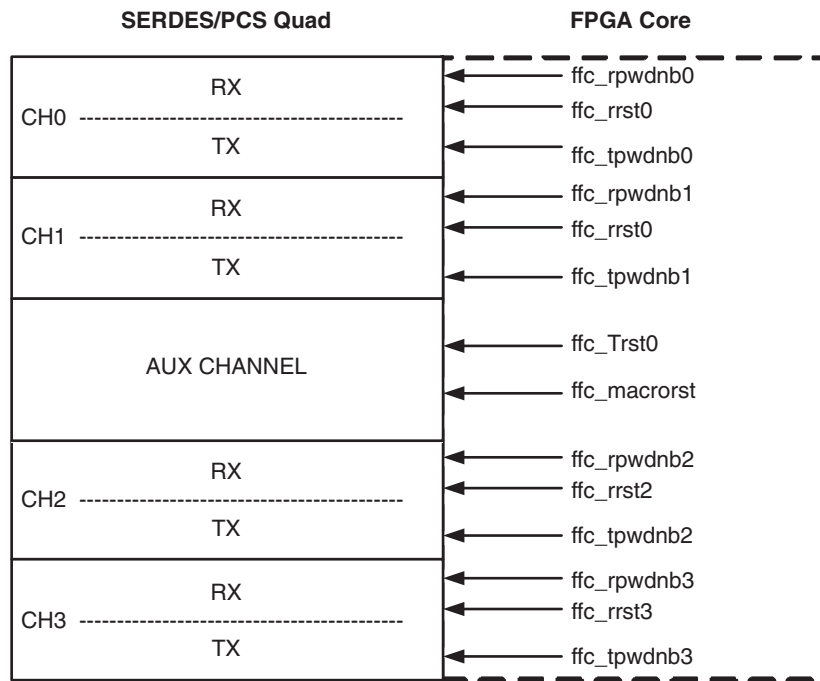
Also, unused SERDES is configured in power down mode by default.

Reset and Power-Down Control

The SERDES quad has reset and power-down controls for the whole macro as well as individual reset and power-down controls for each transmitter and receiver as shown in Figure 8-44. The reset signals are active high and the power-down signals are active low. The operation of the various reset and power-down controls are described in the following sections.

Note: When the device is powering up and the chip level power-on-reset is active, the SERDES control bits (in the PCS) will be cleared (or will take on their default value). This will put the SERDES quad into the power-down state.

Figure 8-44. SERDES/PCS Quad Reset and Power-Down Controls



Reset generation and distribution is handled by the clocks and resets block. Typically, all resets are via hard reset and various FPGA fabric resets. Reset pulse widths are a function of the source. However, all should be at least a clock wide. The reset logic is shown in Figure 8-45 and the corresponding table is in Table 8-25.

Table 8-25. SERDES/PCS Reset Table

| Reset Signals | | PCS ¹ TX | PCS ¹ RX | SERDES TX | SERDES RX | PCS CTRL Registers | TX PLL | CDR PLL |
|-------------------------------|------------------------|------------------------|------------------------|--------------|--------------|--------------------------|-----------|------------|
| FPGA | Control Register | | | | | | | |
| ffc_lane_tx_rst_ch[3:0] | lane_tx_rst[3:0] | X | | | | | | |
| ffc_lane_rx_rst_ch[3:0] | lane_rx_rst[3:0] | | X | | | | | |
| ffc_quad_rst | quad_rst | X | X | X | X | | X | X |
| ffc_macro_rst | macro_rst | | | X | X | | X | X |
| ffc_rrst_ch[3:0] ² | rrst[3:0] ² | | | | X | | | |
| ffc_trst_ch[3:0] ³ | trst[3:0] ³ | | | | | | X | |
| TRI_ION (configuration) | | X | X | X | X | X | | |

1. Includes SB (SERDES Bridge), PCS core and FB (FPGA Bridge) sub-blocks.
2. For internal use only. This reset should always be tied to '0'.
3. Only resets TX PLL loss of lock (ffx_plol).

Figure 8-45. SERDES/PCS Reset Diagram

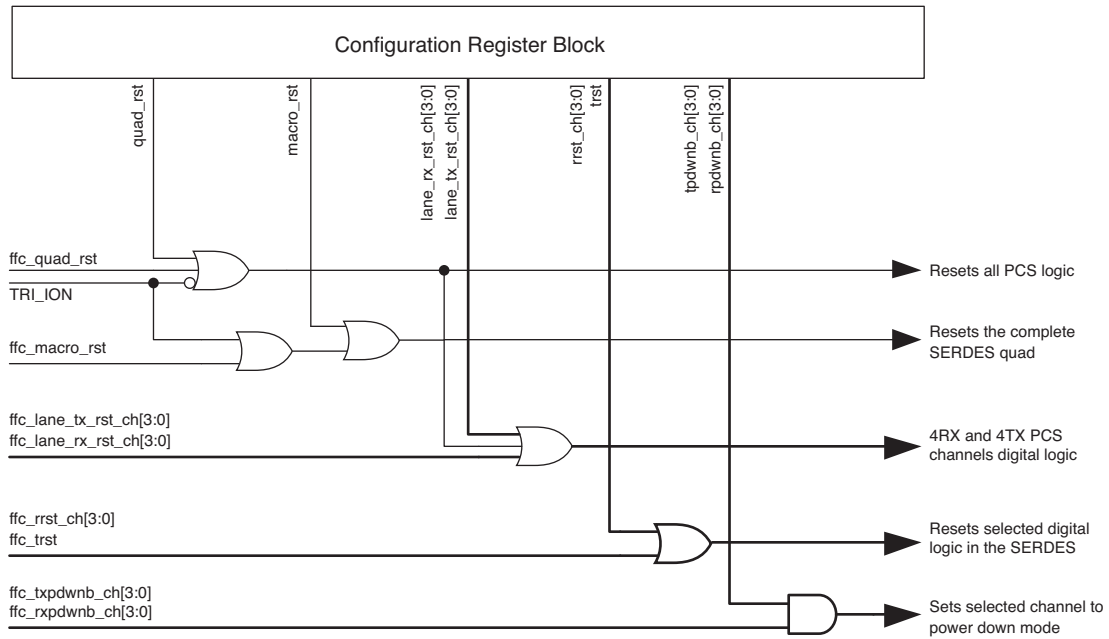


Table 8-26. Reset Controls Description^{1, 2, 3}

| Rest Signal | | Description |
|----------------------------|---------------------|---|
| FPGA | Control Register | |
| ffc_quad_rst | quad_rst | Active high, asynchronous input. Resets all SERDES channels including the auxiliary channel and PCS. This reset includes macro_rst, txpll, cdr, lane_tx_rst, and lane_rx_rst. |
| ffc_macro_rst | macro_rst | Active high, asynchronous input to the SERDES quad. Gated with software register bit. This reset is for the SERDES block only and TXPLL and CDRPLL are included. |
| ffc_lane_tx/rx_rst_ch[0:3] | lane_tx/rx_rst[0:3] | Active high, asynchronous input. Resets individual TX/RX channel in SB, PCS core and FB blocks. |
| ffc_rrst_ch[0:3] | rrst[0:3] | Resets loss-of-lock (rlo) and loss-of-signal circuits. Does not reset CDR PLL. |
| ffc_trst | trst | Resets the loss-of-lock of AUX PLL (plo). |

1. For all channels in the quad running in full-data-rate mode, parallel side clocks are guaranteed to be in-phase.
2. For all channels in the quad running in half-data-rate mode, each channel has a separate divide-by-two circuit. Since there is no mechanism in the quad to guarantee that these divide by two circuits are in phase after de-assertion of “macrorst”, the PCS design should assume that the dividers (and therefore the parallel side clocks) are NOT in phase.
3. In half-data-rate mode, since there is no guarantee that the parallel side clocks are in phase, this may add channel-to-channel skew to both transmit and receive sides of a multi-channel link.

Power-Down Controls Description

Each Rx and Tx channel can be individually powered-down by a software register bit or a control signal from the FPGA. The individual channel power-down control bits will only power down selected blocks within the SERDES macro and the high-speed I/O buffers.

Table 8-27. Power-Down Controls Descriptions

| Signal | | Description |
|--------------------|------------|--|
| FPGA | Register | |
| macropdb | | Active low asynchronous input to the SERDES quad, acts on all channels including the auxiliary channel. When driven low, it powers down the whole macro including the transmit PLL. All clocks are stopped and the macro power dissipation is minimized. |
| ffc_txpwnb_ch[0:3] | tpwnb[0:3] | Active Low Transmit Channel Power Down – Powers down the serializer and output driver. |
| ffc_rxpwnb_ch[0:3] | rpwnb[0:3] | Active Low Receive Channel Power Down – Powers down CDR, input buffer (equalizer and amplifier) and loss-of-signal detector. |

Table 8-28. Reset Pulse Specification

| Parameter | Description | Min. | Typ. | Max. | Units |
|-----------------------|----------------------------|------|------|------|-------|
| t _{MACRORST} | Macro reset high time | 1 | | | μs |
| t _{RRST} | Channel RX reset high time | 3 | | | ns |
| t _{TRST} | Quad TX reset high time | 3 | | | ns |

Table 8-29. Power-Down/Power-Up Timing Specification

| Parameter | Description | Min. | Typ. | Max. | Unit |
|--------------------|--------------------------------|------|------|------|------|
| t _{PWRDN} | Power-down time after macropdb | | | 10 | μs |
| t _{PWRUP} | Power-up time after macropdb | | | 100 | μs |

SERDES/PCS Reset

Reset Sequence and Reset State Diagram

After power-up and configuration, all SERDES resets and FPGA resets are applied.

Lock Status Signals Definitions

| | |
|---------------------|---|
| ffs_plol | : 1 = TX PLL loss of lock. : 0 = TX PLL lock. It takes 1,400,000 UI to declare the lock of the TX PLL. |
| ffs_rlol_ch[3:0] | : 1 = CDR loss of lock. : 0 = Lock maintained. It takes 400,000 reference clock cycles (worst case) to declare the lock of the CDR PLL. |
| ffs_rlos_lo_ch[3:0] | : 1 = Loss of signal detection for each channel. : 0 = Signal detected. |

The ffs_rlol_ch[3:0] status signal is an indicator of the CDR lock status as defined above. However, during the CDR locking process, the CDR PLL will lock to the reference clock when there is no input data present. This purpose of this feature is to avoid ignoring the input data when it is restored.

In order to ensure the presence of input data during CDR lock status checking, it is recommended to use the ffs_rlos_lo_ch[3:0] signal in conjunction with the ffs_rlol_ch[3:0] signal.

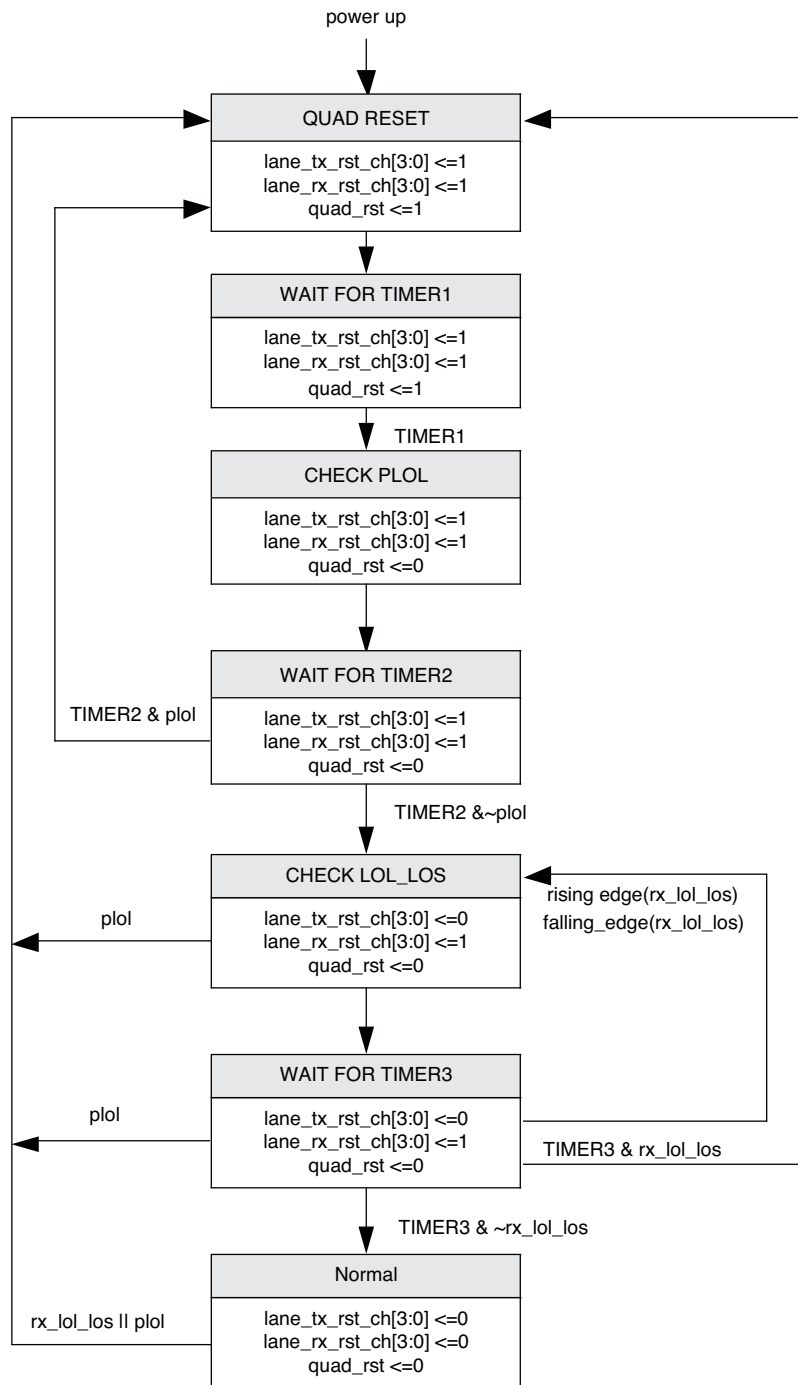
In most applications, combining the two status signals, ffs_rlol_ch[3:0]_s and ffs_rlos_lo_ch[3:0], will work as the indicator of loss of CDR lock. But in applications where high-speed traffic is heavily loaded (i.e. multi-channel, multi-quad), ffs_rlos_lo_ch[3:0] may not represent the correct signal status due to the sensitive nature of the detection circuit. It is strongly recommended to use the protocol-level CDR lock status signal in the RX reset sequence instead of ffs_rlol_ch[3:0].

Reset Sequence

0. QUAD_RESET – At power up, assert ffc_quad_rst, ffc_lane_tx_rst_ch[3:0] and ffc_lane_rx_rst_ch[3:0].
1. WAIT_FOR_TIMER1 – Start TIMER1. Wait a minimum of 20 ns.
2. CHECK_PLOL – Release ffc_quad_rst.
3. WAIT_FOR_TIMER2 – Start TIMER2. If TIMER2 expires and the TX PLL is not locked, go to step 0.
4. CHECK_LOL_LOS – Wait for rx_lol_los[3:0] to go low. Reset TIMER3.
5. WAIT_FOR_TIMER3 – Wait for both ffs_rlol_ch[3:0] and ffs_rlos_lo_ch[3:0] to go low
If there is a transition in rx_lol_los (ffs_rlol_ch[3:0] || ffs_rlos_lo_ch[3:0]), go to step 4.
If TIMER2 expires with rx_lol_los = 1, go to step 0.
6. NORMAL – Release ffc_lane_tx_rst_ch[3:0]. If ffs_plol goes high during normal operation, go to step 0.

The reset sequence state diagram is described in Figure 8-46.

Figure 8-46. Reset State Diagram



- Notes:
- TIMER1: ffc_quad_rst asserted for a minimum of 20 ns.
 - TIMER2: Time to declare TX PLL lock : 1,400,000 UI.
 - TIMER3: Time for rx_loI_loS signal to stay low (400,000 reference clock cycles). Any FPGA clock can be used to satisfy the timer requirement.

In Figure 8-46, rx_loI_loS is defined as ffs_rloI_ch[3:0] || ffs_rloS_lo_ch[3:0]. If a protocol-level CDR lock status signal is provided, it can replace the ffs_rloI_ch[3:0] signal.

Power Supply Sequencing Requirements

When using the SERDES with 1.5V VCCIB or VCCOB, the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and the 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in ramp_up times of power supplies and voltage regulators is not a concern.

References

- Technical notes:
 - TN1029, [FPSC SERDES CML Buffer Interface](#)
 - TN1084, [LatticeSC SERDES Jitter](#)
 - TN1114, [Electrical Recommendations for Lattice SERDES](#)
 - TN1159, [LatticeECP2/M Pin Assignment Recommendations](#)
- HB1003, [LatticeECP2/M Family Handbook](#)

Technical Support Assistance

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e-mail: techsupport@latticesemi.com
Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|---|
| September 2006 | 01.0 | Initial release. |
| March 2007 | 02.0 | Re-formatted and updated majority of the document to clarify the SERDES functionality in detail. |
| August 2007 | 02.1 | SD-SDI and HD-SDI are added in full-support list. Reset sequence, Simulation Consideration, 16-bit word alignment sections added. Plus various updates. |
| September 2007 | 02.2 | Updated Supported SERDES Standards table. Added Simulation of the SERDES/PCS section. |
| December 2007 | 02.3 | TDRV_DAT_SEL tables updated for ECP2M-35 and the rest of ECP2M families. |
| February 2008 | 02.4 | Added detailed Reset Sequence diagram. |
| May 2008 | 02.5 | SCI Address Map updated. Clock usage example table updated. Control register CH_07[2:0] corrected. |
| August 2008 | 02.6 | Updated High Speed I/O Terminations figure. |
| October 2008 | 02.7 | Updated Serializer/Deserializer Blocks latency Corrected footnote 5 in the SERDES_PCS I/O Descriptions table. Changed title of Per Channel Register Settings for Different Standards table to K Characters Recognized for Different Standards. |
| November 2008 | 02.8 | Detailed definitions of reset signals added. |
| January 2009 | 02.9 | Removed references to PIPE Mode. |
| March 2009 | 03.0 | Mode-specific control and status signals are now arranged in one table (Data Bus Usage by Mode table). In all user modes, CTC is bypassed by hardware (SERDES/PCS GUI - PCS Advanced Setup Tab table). |
| May 2009 | 03.1 | Word Aligner Latency value updated. |
| July 2009 | 03.2 | ffc_txpwnb description corrected. rol settling time changed to 4ms. |
| February 2010 | 03.3 | SERDES/PCS reset sequence updated. |
| June 2010 | 03.4 | Added Appendix E. |
| September 2011 | 03.5 | SERDES_PCS I/O Descriptions table – Updated description for ffc_macro_rst signal. SERDES/PCS Reset diagram – Replaced lowest OR gate with an AND gate. Reset Pulse Specification table – Units for t_{MACRORST} changed from ns to μs . SERDES Control Register 3 (QD_13) table – Default for CDR_LOL_SET [1:0] bit changed from 2'b10 to 2'b00. |

Appendix A. Memory Map

Configuration Register Definition

There are specific quad-level registers and channel-level registers. In each category, there are SERDES specific registers and PCS specific registers. Within these sub-categories there are:

- Control registers
- Status registers
- Status registers with clear-on-read
- Interrupt Control registers
- Interrupt Status registers
- Interrupt Source registers (clear-on-read)

All register bits shown below are with D0 as the LEAST significant bit on the right.

The following indications are the nomenclature for what types of register each is: (R/W = Read/Write, RO = Read Only, CR = Clear on a read).

Each of these register bits is “shadowed” with a memory cell. These memory cells are only programmable through bitstream control. After configuration is complete, the configuration memory cells that have associated registers are automatically copied into the registers. Subsequent changes to the contents of the registers will not affect the value stored in the configuration memory cells but will change the operation of the SERDES/PCS quad.

All “reserved” bits are written to zero.

Per Quad Register Overview

Table 8-30. Quad Interface Register Map

| BA ¹ | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|--|------------------------|---------------------------------|--------------------------|--------------------------|--------------------------|---------------------------|---------------------------|---------------------------|---------------------------|
| 1. PER QUAD CONTROL REGISTERS (28) | | | | | | | | | |
| Per Quad PCS Control Registers (17) | | | | | | | | | |
| 00 | qd_00 | sync_toggle | force_int | char_mode | xge_mode | rio_mode | pcie_mode | fc_mode | uc_mode ⁵ |
| 01 | qd_01 | bist_rpt_ch_sel[1] ⁶ | bist_rpt_ch_sel[0] | bist_res_sel[1] | bist_res_sel[0] | bist_time_sel[1] | bist_time_sel[0] | bist_head_sel[1] | bist_head_sel[0] |
| 02 | qd_02 | high_mark[3] | high_mark[2] | high_mark[1] | high_mark[0] | low_mark[3] | low_mark[2] | low_mark[1] | low_mark[0] |
| 03 | qd_03 | min_ipg_cnt[1] | min_ipg_cnt[0] | match_4_enable | match_2_enable | | pfifo_clr_sel | asyn_mode | sel_test_clk |
| 04 | qd_04 | cc_match_1[7] | cc_match_1[6] | cc_match_1[5] | cc_match_1[4] | cc_match_1[3] | cc_match_1[2] | cc_match_1[1] | cc_match_1[0] |
| 05 | qd_05 | cc_match_2[7] | cc_match_2[6] | cc_match_2[5] | cc_match_2[4] | cc_match_2[3] | cc_match_2[2] | cc_match_2[1] | cc_match_2[0] |
| 06 | qd_06 | cc_match_3[7] | cc_match_3[6] | cc_match_3[5] | cc_match_3[4] | cc_match_3[3] | cc_match_3[2] | cc_match_3[1] | cc_match_3[0] |
| 07 | qd_07 | cc_match_4[7] | cc_match_4[6] | cc_match_4[5] | cc_match_4[4] | cc_match_4[3] | cc_match_4[2] | cc_match_4[1] | cc_match_4[0] |
| 08 | qd_08 | cc_match_4[9] | cc_match_4[8] | cc_match_3[9] | cc_match_3[8] | cc_match_2[9] | cc_match_2[8] | cc_match_1[9] | cc_match_1[8] |
| 09 | qd_09 | udf_comma_mask[7] | udf_comma_mask[6] | udf_comma_mask[5] | udf_comma_mask[4] | udf_comma_mask[3] | udf_comma_mask[2] | udf_comma_mask[1] | udf_comma_mask[0] |
| 0A | qd_0a | udf_comma_a[7] | udf_comma_a[6] | udf_comma_a[5] | udf_comma_a[4] | udf_comma_a[3] | udf_comma_a[2] | udf_comma_a[1] | udf_comma_a[0] |
| 0B | qd_0b | udf_comma_b[7] | udf_comma_b[6] | udf_comma_b[5] | udf_comma_b[4] | udf_comma_b[3] | udf_comma_b[2] | udf_comma_b[1] | udf_comma_b[0] |
| 0C | qd_0c | udf_comma_a[9] | udf_comma_a[8] | udf_comma_b[9] | udf_comma_b[8] | udf_comma_mask[9] | udf_comma_mask[8] | bist_mode | bist_en |
| 0D | qd_0d | bist_udf_def_header[7] | bist_udf_def_header[6] | bist_udf_def_header[5] | bist_udf_def_header[4] | bist_udf_def_header[3] | bist_udf_def_header[2] | bist_udf_def_header[1] | bist_udf_def_header[0] |
| 0E | qd_0e | bist_udf_def_header[15] | bist_udf_def_header[14] | bist_udf_def_header[13] | bist_udf_def_header[12] | bist_udf_def_header[11] | bist_udf_def_header[10] | bist_udf_def_header[9] | bist_udf_def_header[8] |
| 0F | qd_0f | bist_bus8bit_sel | bist_ptn_sel[2] | bist_ptn_sel[1] | bist_ptn_sel[0] | bist_udf_def_header[19] | bist_udf_def_header[18] | bist_udf_def_header[17] | bist_udf_def_header[16] |
| 10 | qd_int_10 ² | ls_sync_status_3_int_ctl | ls_sync_status_2_int_ctl | ls_sync_status_1_int_ctl | ls_sync_status_0_int_ctl | ls_sync_statusn_3_int_ctl | ls_sync_statusn_2_int_ctl | ls_sync_statusn_1_int_ctl | ls_sync_statusn_0_int_ctl |
| Per Quad SERDES Control Registers (6) | | | | | | | | | |
| 11 | qd_11 | reserved | reserved | tx_refck_sel | refck_dcc_en | refck_rterm | refck_out_sel[2] | refck_out_sel[1] | refck_out_sel[0] |
| 12 | qd_12 | refck25x | bus8bit_sel | rlos_hset[2] | rlos_hset[1] | rlos_hset[0] | rlos_lset[2] | rlos_lset[1] | rlos_lset[0] |
| 13 | qd_13 | refck_mode[1] | refck_mode[0] | reserved | reserved | reserved | reserved | cdr_lo_lset[1] | cdr_lo_lset[0] |
| 14 | qd_14 | reserved | reserved | reserved | pll_lo_lset[1] | pll_lo_lset[0] | tx_vco_ck_div[2] | tx_vco_ck_div[1] | tx_vco_ck_div[0] |
| 15 | qd_15 | reserved | reserved | reserved | reserved | reserved | reserved | reserved | reserved |
| 16 | qd_int_16 ² | plol_int_ctl | ~plol_int_ctl | reserved | reserved | reserved | reserved | reserved | reserved |
| Per Quad Clock Reset Registers (5) | | | | | | | | | |
| 17 | qd_17 | lane_rx_rst3 | lane_rx_rst2 | lane_rx_rst1 | lane_rx_rst0 | lane_tx_rst3 | lane_tx_rst2 | lane_tx_rst1 | lane_tx_rst0 |
| 18 | qd_18 | macropdb | macro_rst | quad_rst | trst | rrst[3] | rrst[2] | rrst[1] | rrst[0] |
| 19 | qd_19 | bist_rx_data_sel | bist_bypass_tx_gate | bist_sync_head_req[1] | bist_sync_head_req[0] | sel_sd_rx_clk3 | sel_sd_rx_clk2 | sel_sd_rx_clk1 | sel_sd_rx_clk0 |
| 1A | qd_1a | ff_rx_clk_sel_2[3] | ff_rx_clk_sel_2[2] | ff_rx_clk_sel_2[1] | ff_rx_clk_sel_2[0] | ff_rx_clk_sel_1[3] | ff_rx_clk_sel_1[2] | ff_rx_clk_sel_1[1] | ff_rx_clk_sel_1[0] |
| 1B | qd_1b | ff_tx_clk_sel[2] | ff_tx_clk_sel[1] | ff_tx_clk_sel[0] | reserved | ff_rx_clk_sel_0[3] | ff_rx_clk_sel_0[2] | ff_rx_clk_sel_0[1] | ff_rx_clk_sel_0[0] |
| 2. PER QUAD STATUS REGISTERS (9) | | | | | | | | | |
| Per Quad PCS Status Registers (5) | | | | | | | | | |
| 20 | qd_20 | | | | int_qua_out | int_cha[3] | int_cha[2] | int_cha[1] | int_cha[0] |
| 21 | qd_21 ³ | ls_sync_status_3 | ls_sync_status_2 | ls_sync_status_1 | ls_sync_status_0 | ls_sync_statusn_3 | ls_sync_statusn_2 | ls_sync_statusn_1 | ls_sync_statusn_0 |
| 22 | qd_int_22 ⁴ | ls_sync_status_3_int | ls_sync_status_2_int | ls_sync_status_1_int | ls_sync_status_0_int | ls_sync_statusn_3_int | ls_sync_statusn_2_int | ls_sync_statusn_1_int | ls_sync_statusn_0_int |
| 23 | qd_23 | bist_report[7] | bist_report[6] | bist_report[5] | bist_report[4] | bist_report[3] | bist_report[2] | bist_report[1] | bist_report[0] |
| 24 | qd_24 | bist_report[15] | bist_report[14] | bist_report[13] | bist_report[12] | bist_report[11] | bist_report[10] | bist_report[9] | bist_report[8] |
| Per Quad SERDES Status Registers (4) | | | | | | | | | |
| 25 | qd_25 ³ | plol | ~plol | reserved | reserved | reserved | reserved | reserved | reserved |
| 26 | qd_int_26 ⁴ | plol_int | ~plol_int | reserved | reserved | reserved | reserved | reserved | reserved |
| 27 | qd_27 | reserved | reserved | pll_calib_status[5] | pll_calib_status[4] | pll_calib_status[3] | pll_calib_status[2] | pll_calib_status[1] | pll_calib_status[0] |
| 28 | qd_28 | reserved | reserved | reserved | reserved | reserved | reserved | reserved | reserved |

1. BA = Base Address (Hex)
 2. Interrupt control register related to an interruptible status (int_sts_x) register.
 3. Status register which has an associated interruptible status (int_sts_x) register.
 4. Interruptible status register; clear on read (has associated control register and status register)
 5. uc_mode: 8-bit SERDES Only and 10-bit SERDES Only.
 6. BIST is a built-in PRBS generator and checker for internal use only.
 Note: Default value is "0", unless otherwise specified.

Per Quad PCS Control Register Details

Table 8-31. PCS Control Register 1 (QD_00)

| Bit | Name | Description | Type | Default |
|-----|-------------|---|------|---------|
| 7 | sync_toggle | Transition = Reset the 4 Tx Serializer to minimize Tx Lane-to-Lane Skew Level = Normal operation of Tx Serializers | | |
| 6 | force_int | 1 = Force to generate interrupt signal 0 = Normal operation | R/W | 0 |
| 5 | char_mode | 1 = Enable SERDES characterization mode 0 = Disable SERDES characterization mode | R/W | 0 |
| 4 | xge_mode | 1 = Selects 10Gb Ethernet 0 = Selects 1Gb Ethernet mode | R/W | 0 |
| 3 | rio_mode | 1 = Selects Rapid-IO mode 0 = Selects other mode (10GbE, 1GbE) | R/W | 0 |
| 2 | pcie_mode | 1 = PCI Express mode of operation 0 = Selects other mode (RapidIO, 10GbE, 1GbE) | R/W | 0 |
| 1 | fc_mode | 1 = Select Fibre Channel mode 0 = Selects other mode (PCI Express, RapidIO, 10GbE, 1GbE) | R/W | 0 |
| 0 | uc_mode | 1 = Selects User Configured mode 0 = Selects other mode (PCI Express, RapidIO, 10GbE, 1GbE) | | |

Note: Bits 0 to 3 are mutually exclusive. Only one of the bits can be set.

Table 8-32. PCS Control Register 2 (QD_01)

| Bit | Name | Description | Type | Default |
|-----|-----------------------|---|------|---------|
| 7:6 | bist_rpt_ch_sel [1:0] | 00 = BIST report from channel 0 01 = BIST report from channel 1 10 = BIST report from channel 2 11 = BIST report from channel 3 | R/W | 00 |
| 5:4 | bist_res_sel [1:0] | BIST resolution selection 00 = no error 01 < 2 errors 10 < 16 errors 11 < 128 errors | R/W | 00 |
| 3:2 | bist_time_sel [1:0] | BIST time selection: 00 = 5e+8 cycles 01 = 5e+9 cycles 10 = 5e+6 cycles 11 = 100K cycles | R/W | 00 |
| 1:0 | bist_head_sel [1:0] | BIST header selection 00 = K28_5 (K28_5=10'h305 K28_5_=10'h0FA) 01 = A1A2 (MA1=10'h1F6; MA2=10'h128) 10 = 10'h1BC 11 = user defined | R/W | 0 |

Table 8-33. PCS Control Register 3 (QD_02)

| Bit | Name | Description | Type | Default |
|-----|-----------------|--|------|---------|
| 7:4 | high_mark [3:0] | Clock compensation FIFO high water mark. Mean is 4'b1000 | R/W | 4'b0111 |
| 3:0 | low_mark [3:0] | Clock compensation FIFO low water mark. Mean is 4'b1000 | R/W | 4'b1001 |

Table 8-34. PCS Control Register 4 (QD_03)

| Bit | Name | Description | Type | Default |
|-----|-------------------|--|------|---------|
| 7:6 | min_ipg_cnt [1:0] | Minimum IPG to enforce | R/W | 2'b11 |
| 5 | match_4_enable | 1 = enable four character skip matching (using match 4, 3, 2, 1) | R/W | 0 |
| 4 | match_2_enable | 1 = enable two character skip matching (using match 4,3) | R/W | 1 |
| 3 | Reserved | | | |
| 2 | pfifo_clr_sel | 1 = pfifo_clr signal or channel register bit clears the FIFO 0 = pfifo_error internal signal self clears the FIFO | R/W | 0 |
| 1 | asyn_mode | For test only, select asynchronous reset | R/W | 0 |
| 0 | sel_test_clk | For test only, select test clock | R/W | 0 |

Table 8-35. PCS Control Register 5 - CC match 1 LO (QD_04)

| Bit | Name | Description | Type | Default |
|-----|------------------|---|------|---------|
| 7:0 | cc_match_1 [7:0] | Lower bits of user defined clock compensator skip pattern 1 | R/W | 8'h00 |

Table 8-36. PCS Control Register 6 - CC match 2 LO (QD_05)

| Bit | Name | Description | Type | Default |
|-----|------------------|---|------|---------|
| 7:0 | cc_match_2 [7:0] | Lower bits of user defined clock compensator skip pattern 2 | R/W | 8'h00 |

Table 8-37. PCS Control Register 7 - CC match 3 LO (QD_06)

| Bit | Name | Description | Type | Default |
|-----|------------------|---|------|---------|
| 7:0 | cc_match_3 [7:0] | Lower bits of user defined clock compensator skip pattern 3 | R/W | 8'hBC |

Table 8-38. PCS Control Register 8 - CC match 4 LO (QD_07)

| Bit | Name | Description | Type | Default |
|-----|------------------|---|------|---------|
| 7:0 | cc_match_4 [7:0] | Lower bits of user defined clock compensator skip pattern 4 | R/W | 8'h50 |

Table 8-39. PCS Control Register 9 - CC match HI (QD_08)

| Bit | Name | Description | Type | Default |
|-----|------------------|---|------|---------|
| 7:6 | cc_match_4 [9:8] | Upper bits of user defined clock compensator skip pattern 4 [9] = Disparity error [8] = K control | R/W | 2'b01 |
| 5:4 | cc_match_3 [9:8] | Upper bits of user defined clock compensator skip pattern 3 [9] = Disparity error [8] = K control | R/W | 2'b01 |
| 3:2 | cc_match_2 [9:8] | Upper bits of user defined clock compensator skip pattern 2 [9] = Disparity error [8] = K control | R/W | 2'b00 |
| 1:0 | cc_match_1 [9:8] | Upper bits of user defined clock compensator skip pattern 1 [9] = Disparity error [8] = K control | R/W | 2'b00 |

Table 8-40. PCS Control Register 10 - UDF comma mask LO (QD_09)

| Bit | Name | Description | Type | Default |
|-----|----------------------|---------------------------------------|------|---------|
| 7:0 | udf_comma_mask [7:0] | Lower bits of user defined comma mask | R/W | 8'hFF |

Table 8-41. PCS Control Register 11 - UDF comma a LO (QD_0A)

| Bit | Name | Description | Type | Default |
|-----|-------------------|--|------|---------|
| 7:0 | udf_comma_a [7:0] | Lower bits of user defined comma character 'a' | R/W | 8'h83 |

Table 8-42. PCS Control Register 12 - UDF comma b LO (QD_0B)

| Bit | Name | Description | Type | Default |
|-----|-------------------|--|------|---------|
| 7:0 | udf_comma_b [7:0] | Lower bits of user defined comma character 'b' | R/W | 8'h7C |

Table 8-43. PCS Control Register 13 - UDF comma HI (QD_0C)

| Bit | Name | Description | Type | Default |
|-----|----------------------|---|------|---------|
| 7:6 | udf_comma_a [9:8] | Upper bits of user defined comma character 'a' | R/W | 2'b10 |
| 5:4 | udf_comma_b [9:8] | Upper bits of user defined comma character 'b' | R/W | 2'b01 |
| 3:2 | udf_comma_mask [9:8] | Upper bits of user defined comma mask | R/W | 2'b11 |
| 1 | bist_mode | 1 = Continuous Bist Mode 0 = Timed BIST mode | R/W | 0 |
| 0 | bist_en | 1 = Enable PCS BIST 0 = Normal operation. | R/W | 0 |

Table 8-44. PCS Control Register 14 - UDF BIST header LO (QD_0D)

| Bit | Name | Description | Type | Default |
|-----|---------------------------|--|------|---------|
| 7:0 | bist_udf_def_header [7:0] | Lower bits of user defined header for BIST | R/W | 8'h00 |

Table 8-45. PCS Control Register 15 - UDF BIST header MD (QD_0E)

| Bit | Name | Description | Type | Default |
|-----|----------------------------|---|------|---------|
| 7:0 | bist_udf_def_header [15:8] | Middle bits of user defined header for BIST | R/W | 8'h00 |

Table 8-46. PCS Control Register 16 - UDF BIST header HI (QD_0F)

| Bit | Name | Description | Type | Default |
|-----|-----------------------------|---|------|---------|
| 7 | bist_bus8bit_sel | 1 = 8 bit data BIST 0 = 10 bit data BIST | R/W | 0 |
| 6:4 | bist_ptn_sel[2:0] | BIST pattern selection: 000 = PRBS11 001 = max data rate 010 = PRBS31 011 = PRBS21100 = K28_5 101 = A1A2110 = 5150 (repeat) 111 = 2120 (repeat) | R/W | 0 |
| 3:0 | bist_udf_def_header [19:16] | High bits of user defined header for BIST | R/W | 8'h00 |

Table 8-47. PCS Interrupt Control Register 17 (QD_10)

| Bit | Name | Description | Type | Default |
|-----|---------------------------|---|------|---------|
| 7 | ls_sync_status_3_int_ctl | 1 = Enable interrupt for ls_sync_status_3 (in sync) 0 = Disable interrupt for ls_sync_status_3 (in sync) | R/W | 0 |
| 6 | ls_sync_status_2_int_ctl | 1 = Enable interrupt for ls_sync_status_2 (in sync) 0 = Disable interrupt for ls_sync_status_2 (in sync) | R/W | 0 |
| 5 | ls_sync_status_1_int_ctl | 1 = Enable interrupt for ls_sync_status_1 (in sync) 0 = Disable interrupt for ls_sync_status_1 (in sync) | R/W | 0 |
| 4 | ls_sync_statusn_3_int_ctl | 1 = Enable interrupt for ls_sync_status_3 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_3 when it goes low (out of sync) | R/W | 0 |
| 4 | ls_sync_status_0_int_ctl | 1 = Enable interrupt for ls_sync_status_0 (in sync) 0 = Disable interrupt for ls_sync_status_0 (in sync) | R/W | 0 |
| 3 | ls_sync_statusn_2_int_ctl | 1 = Enable interrupt for ls_sync_status_2 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_2 when it goes low (out of sync) | R/W | 0 |
| 1 | ls_sync_statusn_1_int_ctl | 1 = Enable interrupt for ls_sync_status_1 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_1 when it goes low (out of sync) | R/W | 0 |
| 0 | ls_sync_statusn_0_int_ctl | 1 = Enable interrupt for ls_sync_status_0 when it goes low (out of sync) 0 = Disable interrupt for ls_sync_status_0 when it goes low (out of sync) | R/W | 0 |

Per Quad SERDES Control Register Details

Note: Except indicated, all channels must be reset after writing any SERDES control register.

Table 8-48. SERDES Control Register 1 (QD_11)

| Bit | Name | Description | Type | Default |
|-----|--------------------|---|------|---------|
| 7:6 | Reserved | | | |
| 5 | TX_REFCK_SEL | TXPLL reference clock select 0 = refclk (differential input) 1 = core_txrefclk | R/W | 0 |
| 4 | REFCK_DCC_EN | 1 = Reference clock DC coupling enable 0 = Reference clock DC coupling disable (default) | R/W | 0 |
| 3 | REFCK_RTERM | Termination at reference clock input buffer 0 = 50 ohm (default) 1 = high impedance | R/W | 0 |
| 2:0 | REFCL_OUT_SEL[2:0] | Refck control [0]: 0 = refck buffer enable, 1 = refck buffer disable [1]: 0 = refck2core disable, 1 = refck2core enable [2]: reserved Refer to Figure 8-47. | R/W | 3'b000 |

Figure 8-47. Reference Clock Select Control

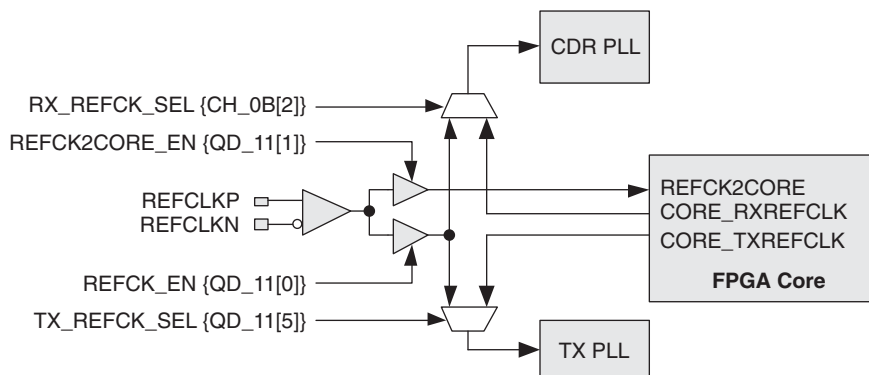


Table 8-49. SERDES Control Register 2 (QD_12)

| Bit | Name | Description | Type | Default |
|-----|-----------------|---|------|---------|
| 7 | REFCK25X | 1 = Internal high speed bit clock is 25x (for reference clock = 100MHz only) 0 = See REFCK_MODE | R/W | 0 |
| 6 | BUS8BIT_SEL | 1 = Select 8-bit bus width 0 = Select 10-bit bus width (default) | R/W | 0 |
| 5:3 | RLOS_HSET [2:0] | LOS detector reference current adjustment for larger swing 000 = default 001 = +10% 010 = +15% 011 = +25% 100 = -10% 101 = -15% 110 = -25% 111 = -30% | R/W | 3'b000 |
| 2:0 | RLOS_LSET [2:0] | (Internal use only) | R/W | 3'b000 |

Table 8-50. SERDES Control Register 3 (QD_13)

| Bit | Name | Description | R/W | Default |
|-----|-------------------|---|-----|--------------------|
| 7:6 | REFCK_MODE [1:0] | 00 = Internal high speed bit clock is 20x or 16x 01 = Internal high speed bit clock is 10x or 8x 1X = Reserved | R/W | 2'b00 |
| 5:2 | Reserved | | | |
| 1:0 | CDR_LOL_SET [1:0] | CDR loss of lock setting: Lock Unlock 00 = +/-1000ppm x2 +/-1500ppm x2 01 = +/-2000ppm x2 +/-2500ppm x2 10 = +/-4000ppm +/-7000ppm 11 = +/-300ppm +/-450ppm | R/W | 2'b00 ¹ |

1. This is the default value used in isplEVER 8.1.

Table 8-51. SERDES Control Register 4 (QD_14)

| Bit | Name | Description | R/W | Default |
|-----|--------------------|---|-----|---------|
| 7:5 | Reserved | | | |
| 4:3 | PLL_LOL_SET [1:0] | TxPLL loss of lock setting Lock Unlock 00 = +/-300ppm x2 +/-600ppm x2 01 = +/-300ppm +/-2000ppm 10 = +/-1500ppm +/-2200ppm 11 = +/-4000ppm +/-6000ppm | R/W | 2'b00 |
| 2:0 | TX_VCO_CK_DIV[2:0] | VCO output frequency select: 000 = divided by 1 001 = reserved 010 = divided by 2 011 = reserved 100 = divided by 4 101 = divided by 8 110 = divided by 16 111 = divided by 32 | R/W | 3'b000 |

Table 8-52. SERDES Control Register 5 (QD_15)

| Bit | Name | Description | R/W | Default |
|-----|----------|-------------|-----|---------|
| 7:0 | Reserved | | | |

Table 8-53. SERDES Interrupt Control Register 6 (QD_16)

| Bit | Name | Description | R/W | Default |
|-----|---------------|---|-------|---------|
| 7 | PLOL_INT_CTL | 1 = Interrupt enabled for loss of lock on PLOL. 0 = Interrupt not enabled for loss of lock PLOL. | RO CR | 0 |
| 6 | ~PLOL_INT_CTL | 1 = Interrupt enabled for obtaining lock on PLOL. 0 = Interrupt not enabled for obtaining lock PLOL. | RO CR | 0 |
| 5:0 | Reserved | | | |

Per Quad Reset and Clock Control Register Details

Table 8-54. Reset and Clock Control Register 1 (QD_17)

| Bit | Name | Description | R/W | Default |
|-----|--------------|---|-----|---------|
| 7 | lane_rx_rst3 | 1 = Assert reset signal to channel 3 receive logic | R/W | 0 |
| 6 | lane_rx_rst2 | 1 = Assert reset signal to channel 2 receive logic | R/W | 0 |
| 5 | lane_rx_rst1 | 1 = Assert reset signal to channel 1 receive logic | R/W | 0 |
| 4 | lane_rx_rst0 | 1 = Assert reset signal to channel 0 receive logic | R/W | 0 |
| 3 | lane_tx_rst3 | 1 = Assert reset signal to channel 3 transmit logic | R/W | 0 |
| 2 | lane_tx_rst2 | 1 = Assert reset signal to channel 2 transmit logic | R/W | 0 |
| 1 | lane_tx_rst1 | 1 = Assert reset signal to channel 1 transmit logic | R/W | 0 |
| 0 | lane_tx_rst0 | 1 = Assert reset signal to channel 0 transmit logic | R/W | 0 |

Table 8-55. Reset and Clock Control Register 2 (QD_18)

| Bit | Name | Description | R/W | Default |
|-----|------------|----------------------------|-----|---------|
| 7 | macropdb | 0 = Assert power down | R/W | 1 |
| 6 | macro_rst | 1 = Assert macro reset | R/W | 0 |
| 5 | quad_rst | 1 = Assert quad reset | R/W | 0 |
| 4 | trst | 1 = Tx Reset | R/W | 0 |
| 3:0 | rrst [3:0] | 1 = Rx channel-based reset | R/W | 0 |

Table 8-56. Reset and Clock Control Register 3 (QD_19)

| Bit | Name | Description | R/W | Default |
|-----|--------------------------|--|-----|---------|
| 7 | bist_rx_data_sel | 0 = data from SERDES 1 = data from after 8b10b decoder | R/W | 0 |
| 6 | bist_bypass_tx_gate | 0 = start to send BIST data after finding the head 1 = force to send BIST data whether the head is found or not | R/W | 0 |
| 5:4 | bist_sync_head_req [1:0] | BIST sync header counter selection 00 = 5'd5 01 = 5'd8 10 = 5'd14 11 = 5'd24 | R/W | 00 |
| 3 | sel_sd_rx_clk3 | 1 = Select rx_clk3 ¹ for DS FIFO write clock 0 = Select ff_ebrd_clk_3 for DS FIFO write clock | R/W | 0 |
| 2 | sel_sd_rx_clk2 | 1 = Select rx_clk2 for DS FIFO write clock 0 = Select ff_ebrd_clk_2 for DS FIFO write clock | R/W | 0 |
| 1 | sel_sd_rx_clk1 | 1 = Select rx_clk1 for DS FIFO write clock 0 = Select ff_ebrd_clk_1 for DS FIFO write clock | R/W | 0 |
| 0 | sel_sd_rx_clk0 | 1 = Select rx_clk0 for DS FIFO write clock 0 = Select ff_ebrd_clk_0 for DS FIFO write clock | R/W | 0 |

1. rx_clk3 is channel3 recovered clock.

Table 8-57. Reset and Clock Control Register 4 (QD_1A)

| Bit | Name | Description | R/W | Default |
|-----|------------------|---------------------------------------|-----|---------|
| 7 | ff_rx_clk_sel3_2 | 1 = Disable ff_rx_f_clk for channel 3 | R/W | 0 |
| 6 | ff_rx_clk_sel2_2 | 1 = Disable ff_rx_f_clk for channel 2 | R/W | 0 |
| 5 | ff_rx_clk_sel1_2 | 1 = Disable ff_rx_f_clk for channel 1 | R/W | 0 |
| 4 | ff_rx_clk_sel0_2 | 1 = Disable ff_rx_f_clk for channel 0 | R/W | 0 |
| 3 | ff_rx_clk_sel3_1 | 1 = Enable ff_rx_h_clk for channel 3 | R/W | 0 |
| 2 | ff_rx_clk_sel2_1 | 1 = Enable ff_rx_h_clk for channel 2 | R/W | 0 |
| 1 | ff_rx_clk_sel1_1 | 1 = Enable ff_rx_h_clk for channel 1 | R/W | 0 |
| 0 | ff_rx_clk_sel0_1 | 1 = Enable ff_rx_h_clk for channel 0 | R/W | 0 |

Table 8-58. Reset and Clock Control Register 5 (QD_1B)

| Bit | Name | Description | R/W | Default |
|-----|------------------|--------------------------------------|-----|---------|
| 7 | ff_tx_clk_sel2 | 1 = Disable ff_tx_f_clk for quad | R/W | 0 |
| 6 | ff_tx_clk_sel1 | 1 = Enable ff_tx_h_clk for quad | R/W | 1 |
| 5 | ff_tx_clk_sel0 | 1 = Enable ff_tx_q_clk for quad | R/W | 0 |
| 4 | Reserved | | | |
| 3 | ff_rx_clk_sel3_0 | 1 = Enable ff_rx_q_clk for channel 3 | R/W | 0 |
| 2 | ff_rx_clk_sel2_0 | 1 = Enable ff_rx_q_clk for channel 2 | R/W | 0 |
| 1 | ff_rx_clk_sel1_0 | 1 = Enable ff_rx_q_clk for channel 1 | R/W | 0 |
| 0 | ff_rx_clk_sel0_0 | 1 = Enable ff_rx_q_clk for channel 0 | R/W | 0 |

Per Quad PCS Status Register Details

Table 8-59. PCS Status Register 1 (QD_20)

| Bit | Name | Description | R/W | Int? |
|-----|-------------------|------------------------------------|-----|------|
| 7:6 | Reserved | | | |
| 5 | ion_delay | Delayed global resetn from tri_ion | RO | N |
| 4 | int_qua_out | Per Quad Interrupt status | RO | N |
| 3:0 | int_cha_out [3:0] | Per Channel Interrupt status | RO | N |

Table 8-60. PCS Status Register 2 (QD_21)

| Bit | Name | Description | R/W | Int? |
|-----|-------------------|--|-----|------|
| 7 | ls_sync_status_3 | 1 = Alarm generated on sync_status_3. 0 = Alarm not generated on sync_status_3. | RO | Y |
| 6 | ls_sync_status_2 | 1 = Alarm generated on sync_status_2. 0 = Alarm not generated on sync_status_2. | RO | Y |
| 5 | ls_sync_status_1 | 1 = Alarm generated on sync_status_1. 0 = Alarm not generated on sync_status_1. | RO | Y |
| 4 | ls_sync_status_0 | 1 = Alarm generated on sync_status_0. 0 = Alarm not generated on sync_status_0. | RO | Y |
| 3 | ls_sync_statusn_3 | 1 = Alarm generated on sync_status_3 when it goes low (out of sync) 0 = Alarm not generated on sync_status_3 when it goes low (out of sync) | RO | Y |
| 2 | ls_sync_statusn_2 | 1 = Alarm generated on sync_status_2 when it goes low (out of sync) 0 = Alarm not generated on sync_status_2 when it goes low (out of sync) | RO | Y |
| 1 | ls_sync_statusn_1 | 1 = Alarm generated on sync_status_1 when it goes low (out of sync) 0 = Alarm not generated on sync_status_1 when it goes low (out of sync) | RO | Y |
| 0 | ls_sync_statusn_0 | 1 = Alarm generated on sync_status_0 when it goes low (out of sync) 0 = Alarm not generated on sync_status_0 when it goes low (out of sync) | RO | Y |

Table 8-61. Packet Interrupt Status Register 3 (QD_22)

| Bit | Name | Description | R/W | Int? |
|-----|-----------------------|--|-------|------|
| 7 | ls_sync_status_3_int | 1 = Interrupt generated on sync_status_0 (in sync) 0 = Interrupt not generated on sync_status_0 (in sync) | RO CR | Y |
| 6 | ls_sync_status_2_int | 1 = Interrupt generated on sync_status_1 (in sync) 0 = Interrupt not generated on sync_status_1 (in sync) | RO CR | Y |
| 5 | ls_sync_status_1_int | 1 = Interrupt generated on sync_status_2 (in sync) 0 = Interrupt not generated on sync_status_2 (in sync) | RO CR | Y |
| 4 | ls_sync_status_0_int | 1 = Interrupt generated on sync_status_3 (in sync) 0 = Interrupt not generated on sync_status_3 (in sync) | RO CR | Y |
| 3 | ls_sync_statusn_3_int | 1 = Interrupt generated on sync_status_3 when it goes low (out of sync) 0 = Interrupt not generated on sync_status_3 when it goes low (out of sync) | RO CR | Y |
| 2 | ls_sync_statusn_2_int | 1 = Interrupt generated on sync_status_2 when it goes low (out of sync) 0 = Interrupt not generated on sync_status_2 when it goes low (out of sync) | RO CR | Y |
| 1 | ls_sync_statusn_1_int | 1 = Interrupt generated on sync_status_1 when it goes low (out of sync) 0 = Interrupt not generated on sync_status_1 when it goes low (out of sync) | RO CR | Y |
| 0 | ls_sync_statusn_0_int | 1 = Interrupt generated on sync_status_0 when it goes low (out of sync) 0 = Interrupt not generated on sync_status_0 when it goes low (out of sync) | RO CR | Y |

Table 8-62. PCS BIST Status Register 4 (QD_23)

| Bit | Name | Description | R/W | Int? |
|-----|-------------------|---------------------------|-----|------|
| 7:0 | bist_report [7:0] | Lower bits of BIST report | RO | N |

Table 8-63. PCS BIST Status Register 5 (QD_24)

| Bit | Name | Description | R/W | Int? |
|-----|--------------------|----------------------------|-----|------|
| 7:0 | bist_report [15:8] | Higher bits of BIST report | RO | N |

Per Quad SERDES Status Register Details**Table 8-64. SERDES Status Register 1 (QD_25)**

| Bit | Name | Description | R/W | Int? |
|-----|----------|-----------------------|-----|------|
| 7 | PLOL | 1 = PLL Loss of lock | RO | Y |
| 6 | ~PLOL | 1 = PLL lock obtained | RO | Y |
| 5:0 | Reserved | | | |

Table 8-65. SERDES Interrupt Status Register 2 (QD_26)

| Bit | Name | Description | R/W | Int? |
|-----|-----------|---|-------|------|
| 7 | PLOL_INT | 1 = Interrupt generated on PLOL. 0 = Interrupt not generated PLOL. | RO CR | Y |
| 6 | ~PLOL_INT | 1 = Interrupt generated on ~PLOL. 0 = Interrupt not generated ~PLOL. | RO CR | Y |
| 5:0 | Reserved | | | |

Table 8-66. SERDES Status Register 3 (QD_27)

| Bit | Name | Description | R/W | Int? |
|-----|-----------------------|-------------------------------------|-----|------|
| 7:6 | Reserved | | | |
| 5:0 | PLL_CALIB_STATUS[5:0] | TxPLL VCO calibration status output | RO | N |

Table 8-67. SERDES Status Register 4 (QD_28)

| Bit | Name | Description | R/W | Int? |
|-----|----------|-------------|-----|------|
| 7:0 | Reserved | | | |

Per Channel Register Overview

Table 8-68. Channel Interface Register Map

| BA ¹ | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|--|------------------------|----------------------|--------------------------|---------------------|---------------------|---------------------|--------------------|--------------------------|--------------------------|
| 1. CONTROL REGISTERS (13) | | | | | | | | | |
| Per Channel General Registers (7) | | | | | | | | | |
| 00 | ch_00 | enable_cg_align | prbs_enable ⁶ | prbs_lock | ge_an_enable | | | invert_tx | invert_rx |
| 01 | ch_01 | pfifo_clr | pcie_ei_en | pcs_det_time_sel[1] | pcs_det_time_sel[0] | rx_gear_mode | tx_gear_mode | rx_ch | tx_ch |
| 02 | ch_02 | bus_width8 | sb_bypass | sb_pfifo_lp | sb_bist_sel | enc_bypass | sel_bist_txd4enc | tx_gear_bypass | fb_loopback |
| 03 | ch_03 | lsm_sel | signal_detect | rx_gear_bypass | ctc_bypass | dec_bypass | wa_bypass | rx_sb_bypass | sb_loopback |
| 04 | ch_int_04 ² | | | | | cc_underrun_int_ctl | cc_overrun_int_ctl | fb_rx_fifo_error_int_ctl | fb_tx_fifo_error_int_ctl |
| 05 | ch_05 | | | | | | | | los_hi_sel |
| 06 | ch_06 | | | | | | | | |
| Per Channel SERDES Registers (6) | | | | | | | | | |
| 07 | ch_07 | req_en | req_lv1_set | rcv_dcc_en | rate_sel[1] | rate_sel[0] | rx_dco_ck_div[2] | rx_dco_ck_div[1] | rx_dco_ck_div[0] |
| 08 | ch_08 | lb_ctl[3] | lb_ctl[2] | lb_ctl[1] | lb_ctl[0] | rterm_rxadj[1] | rterm_rxadj[0] | rterm_rx[1] | rterm_rx[0] |
| 09 | ch_09 | tdrv_amp[2] | tdrv_amp[1] | tdrv_amp[0] | tdrv_pre_sel[2] | tdrv_pre_sel[1] | tdrv_pre_sel[0] | tdrv_dat_sel[1] | tdrv_dat_sel[0] |
| 0A | ch_0a | | | | tdrv_pre_en | rterm_tx[1] | rterm_tx[0] | rate_mode_tx | tpwdnb |
| 0B | ch_0b | | | | oob_en | rx_refck_sel[1] | rx_refck_sel[0] | rate_mode_rx | rpwdnb |
| 0C | ch_int_0c ² | | pci_det_done_int_ctl | rlos_lo_int_ctl | ~rlos_lo_int_ctl | rlos_hi_int_ctl | ~rlos_hi_int_ctl | rlol_int_ctl | ~rlol_int_ctl |
| 2. STATUS REGISTERS (13) | | | | | | | | | |
| Per Channel General Registers (6) | | | | | | | | | |
| 20 | ch_20 ³ | | | | | cc_underrun | cc_overrun | fb_rx_fifo_error | fb_tx_fifo_error |
| 21 | ch_21 ⁵ | prbs_error_cnt[7] | prbs_error_cnt[6] | prbs_error_count[5] | prbs_error_cnt[4] | prbs_error_cnt[3] | prbs_error_cnt[2] | prbs_error_cnt[1] | prbs_error_cnt[0] |
| 22 | ch_22 | | | | | | | | |
| 23 | ch_int_23 | fb_tx_fifo_error_int | fb_rx_fifo_error_int | | | cc_underrun_int | cc_overrun_int | fb_rx_fifo_error_int | fb_tx_fifo_error_int |
| 24 | ch_24 | | ffs_ls_sync_status | fb_rxrst_o | fb_txrst_o | | | cc_re_o | cc_we_o |
| 25 | ch_25 | | | | | | | | |
| Per Channel SERDES Registers (7) | | | | | | | | | |
| 26 | ch_26 ³ | | pci_det_done | rlos_lo | ~rlos_lo | rlos_hi | ~rlos_hi | rlol | ~rlol |
| 27 | ch_27 | dco_calib_err | dco_calib_done | dco_facq_err | dco_facq_done | | | | pci_connect |
| 28 | ch_28 | dco_status[7] | dco_status[6] | dco_status[5] | dco_status[4] | dco_status[3] | dco_status[2] | dco_status[1] | dco_status[0] |
| 29 | ch_29 | dco_status[15] | dco_status[14] | dco_status[13] | dco_status[12] | dco_status[11] | dco_status[10] | dco_status[9] | dco_status[8] |
| 2A | ch_int_2a ⁴ | | pci_det_done_int | rlos_lo_int | ~rlos_lo_int | rlos_hi_int | ~rlos_hi_int | rlol_int | ~rlol_int |
| 2B | ch_2b | | | | | | | | |
| 2C | ch_2c | | | | | | | | |

1. BA = Base Address (Hex)
 2. Interrupt control register related to an interruptible status (int_sts_x) register.
 3. Status register which has an associated interruptible status (int_sts_x) register.
 4. Interruptible status register; clear on read (has associated control register and status register).
 5. Status register with clear on read.
 6. PRBS is generated by built-in logic and is for internal test only.
 Note: Default value is "0", unless otherwise specified.

Table 8-69. PCS Control Register 1 (CH_00)

| Bit | Name | Description | R/W | Default |
|-----|-----------------|---|-----|---------|
| 7 | enable_cg_align | Only valid when operating in uc_mode 1 = Enable continuous comma alignment 0 = Disable continuous comma alignment | R/W | 0 |
| 6 | prbs_enable | 1 = Enable PRBS generator & checker 0 = Normal operational mode. | R/W | 0 |
| 5 | prbs_lock | 1 = Lock receive PRBS checker 0 = Unlock receive PRBS checker | R/W | 0 |
| 4 | ge_an_enable | 1 = Enable GIGE Auto Negotiation 0 = Disable GIGE Auto Negotiation | R/W | 0 |
| 3:2 | Reserved | | | |
| 1 | invert_tx | 1 = Invert transmitted data 0 = Do not invert transmitted data. | R/W | 0 |
| 0 | invert_rx | 1 = Invert received data 0 = Do not invert received data. | R/W | 0 |

Table 8-70. PCS Control Register 2 (CH_01)

| Bit | Name | Description | R/W | Default |
|-----|-----------------------|---|-----|---------|
| 7 | pfifo_clr | 1 = Clears PFIFO if quad register bit pfifo_clr_sel is set to 1. This signal is ORed with interface signal pfifo_clr. 0 = Normal operation | R/W | 0 |
| 6 | pcie_ei_en | 1 = PCI Express Electrical Idle 0 = Normal operation | R/W | 0 |
| 5:4 | pcs_det_time_sel[1:0] | PCS connection detection time 11 = 16us 10 = 4us 01 = 2us 00 = 8us | R/W | 0 |
| 3 | rx_gear_mode | 1 = Enable 2:1 gearing for receive path on all channels 0 = Disable 2:1 gearing for receive path on all channels (no gearing) | R/W | 0 |
| 2 | tx_gear_mode | 1 = Enable 2:1 gearing for transmit path on all channels 0 = Disable 2:1 gearing for transmit path on all channels (no gearing) | R/W | 0 |
| 1 | rx_ch | 1 = Receive outputs can be monitored on the test characterization pins. The test characterization mode (bit 6 in pcs_ctl_4_qd_03) should be set to '1'. | R/W | 0 |
| 0 | tx_ch | 1 = Transmit PCS inputs are sourced from test characterization ports. The test characterization mode should be enabled. | R/W | 0 |

Table 8-71. PCS Control Register 3 (CH_02)

| Bit | Name | Description | R/W | Default |
|-----|------------------|---|-----|---------|
| 7 | bus_width8 | 1 = 8-bit bus between PCS and SER 0 = 10-bit bus between PCS and SER. | R/W | 0 |
| 6 | sb_bypass | 1 = Bypass Tx SERDES Bridge 0 = Normal operation | R/W | 0 |
| 5 | sb_pfifo_lp | 1 = Enable Parallel Loopback from Rx to Tx via parallel FIFO 0 = Normal data operation | R/W | 0 |
| 4 | sb_bist_sel | 1 = Select BIST data 0 = Select Normal data | R/W | 0 |
| 3 | enc_bypass | 1 = Bypass 8b10b encoder 0 = Normal operation | R/W | 0 |
| 2 | sel_bist_txd4enc | 1 = Enable BIST data to Tx before 8b10b ENC 0 = Normal operation | R/W | 0 |
| 1 | tx_gear_bypass | 1 = Bypass PCS Tx gear box 0 = Normal operation | R/W | 0 |
| 0 | fb_loopback | 1 = Enable loopback in the PCS just before FPGA bridge from Rx to Tx. 0 = Normal data operation. | R/W | 0 |

Table 8-72. PCS Control Register 4 (CH_03)

| Bit | Name | Description | R/W | Default |
|-----|----------------|--|-----|---------|
| 7 | lsm_sel | 1 = selects External LSM for Word Alignment 0 = selects Internal LSM for Word Alignment | R/W | 0 |
| 6 | signal_detect | 1 = force enabling the Rx link state machine 0 = dependent of ffc_signal_detect to enable the Rx link state machine | R/W | 0 |
| 5 | rx_gear_bypass | 1 = Bypass PCS Rx gear box 0 = Normal operation | R/W | 0 |
| 4 | ctc_bypass | 1 = Bypass clock toleration compensation 0 = Normal operation | R/W | 0 |
| 3 | dec_bypass | 1 = Bypass 8b10b decoder 0 = Normal operation | R/W | 0 |
| 2 | wa_bypass | 1 = Bypass word alignment 0 = Normal operation | R/W | 0 |
| 1 | rx_sb_bypass | 1 = Bypass Rx SERDES Bridge 0 = Normal operation | R/W | 0 |
| 0 | sb_loopback | 1 = Enable loopback in the PCS from Tx to Rx in SERDES bridge. 0 = Normal data operation. | R/W | 0 |

Table 8-73. PCS Interrupt Control Register 5 (CH_04)

| Bit | Name | Description | R/W | Default |
|-----|--------------------------|--|-----|---------|
| 7:4 | Reserved | | | |
| 3 | cc_underrun_int_ctl | 1 = Enable interrupt for cc_underrun 0 = Disable interrupt for cc_underrun. | RW | 0 |
| 2 | cc_overrun_int_ctl | 1 = Enable interrupt for cc_overrun 0 = Disable interrupt for cc_overrun. | RW | 0 |
| 1 | fb_rx_fifo_error_int_ctl | 1 = Enable interrupt on empty/full condition in the receive FPGA bridge FIFO. | R/W | 0 |
| 0 | fb_tx_fifo_error_int_ctl | 1 = Enable interrupt on empty/full condition in the transmit FPGA bridge FIFO. | R/W | 0 |

Table 8-74. PCS Control Register 6 (CH_05)

| Bit | Name | Description | R/W | Default |
|-----|------------|---|-----|---------|
| 7:1 | Reserved | | | |
| 0 | low_hi_sel | 1 = Select rlos_hi 0 = Select rlos_lo (this option is for internal use only) | R/W | 0 |

Table 8-75. PCS Control Register 7 (CH_06)

| Bit | Name | Description | R/W | Default |
|-----|----------|-------------|-----|---------|
| 7:0 | Reserved | | | |

Per Channel SERDES Control Register Details

Note: Except indicated, all channels must be reset after writing any SERDES control register.

Table 8-76. SERDES Control Register 1 (CH_07)

| Bit | Name | Description | R/W | Default |
|-----|--------------------|---|-----|---------|
| 7 | REQ_EN | 1 = Receiver equalization enable 0 = Receiver equalization disable | R/W | 0 |
| 6 | REQ_LVL_SET | Level setting for equalization 1 = long-reach equalization 0 = mid-length route equalization | R/W | 0 |
| 5 | RCV_DCC_EN | 1 = Receiver DC coupling enable. 0 = AC coupling (default) | R/W | 0 |
| 4:3 | RATE_SEL [1:0] | Equalizer pole position select: 00 = pole position for high frequency range 01 = pole position for medium frequency range 10 = pole position for low frequency range 11 = not used | R/W | 2'b00 |
| 2:0 | RX_DCO_CK_DIV[2:0] | VCO output frequency select: 000 = divided by 1 001 = reserved 010 = divided by 2 011 = reserved 100 = divided by 4 101 = divided by 8 110 = divided by 16 111 = divided by 32 | R/W | 3'b000 |

Table 8-77. SERDES Control Register 2 (CH_08)

| Bit | Name | Description | R/W | Default |
|-----|-------------------|---|-----|---------|
| 7:4 | LB_CTL [3:0] | Loop back control: [3] = slb_r2t_dat_en, serial rx to tx LB enable(CDR data) [2] = slb_r2t_ck_en, serial rx to tx LB enable(CDR clock) [1] = slb_eq2t_en, serial LB from equalizer to driver enable [0] = slb_t2r_en, serial tx_to rx LB enable | R/W | 4'h0 |
| 3:2 | RTERM_RXADJ [1:0] | Termination resistor compensation 00 = default 01 = -7% 10 = -14% 11 = -20% | R/W | 2'b00 |
| 1:0 | RTERM_RX [1:0] | 00 = 50 ohm 01 = 75 ohm 10 = 2K ohm 11 = 60 ohm | R/W | 2'b00 |

Table 8-78. SERDES Control Register 3 (CH_09)

| Bit | Name | Description | R/W | Default | | |
|---|-------------------|---|--|----------|-----|---|
| SERDES Control Register 3(CH_09) for LatticeECP2M-35 | | | | | | |
| 7:5 | TDRV_AMP[2:0] | CML driver amplitude setting (mV), VCCOB = 1.2V 000 = 1040(default) 001 = 1280 010 = 1320 011 = 1360 100 = 640 101 = 760 110 = 870 111 = 990 | R/W | 0 | | |
| 4:2 | TDRV_PRE_SET[2:0] | Tx_driver pre-emphasis level setting 0 1 2 3 4 5 6 | % 0 16 36 40 44 56 80 | R/W 0 | | |
| 1:0 | TDRV_DAT_SEL[1:0] | Driver output select: 00 = data from Serializer muxed to driver (normal operation) 01 = data rate clock from Serializer muxed to driver 10 = serial Rx to Tx LB (data) if slb_r2t_dat_en='1' 10 = serial Rx to Tx LB (clock) if slb_r2t_ck_en='1' 11 = serial LB from equalizer to driver if slb_eq2t_en='1' | R/W | 0 | | |
| SERDES Control Register 3(CH_09) for LatticeECP2M-20/50/70/100 | | | | | | |
| 7:5 | TDRV_AMP[2:0] | See Table 8-81 | R/W | 0 | | |
| 4:0 | TDRV_PRE_SET[4:0] | Tx_driver pre-emphasis level setting | | | R/W | 0 |
| | | 3-bit setting in GUI | 5-bit setting in register | % | | |
| | | 0 | 00000 | 0 | | |
| | | 1 | 00001 | 12 | | |
| | | 2 | 00010 | 26 | | |
| | | 3 | 01010 | 30 | | |
| | | 4 | 10010 | 33 | | |
| | | 5 | 00011 | 40 | | |
| | | 6 | 00100 | 53 | | |

Table 8-79. SERDES Control Register 4 (CH_0A)

| Bit | Name | Description | R/W | Default |
|-----|--------------------------------|---|-----|---------|
| 7 | Reserved | | | |
| 6:5 | TDRV_DAT_SEL[1:0] ¹ | Driver output select: 00 = data from Serializer muxed to driver (normal operation) 01 = data rate clock from Serialzer muxed to driver 10 = serial Rx to Tx LB (data) if slb_r2t_data_en='1' 10 = serial Rx to Tx LB (clock) if slb_r2t_ck_en='1' 11 = serial LB from equalizer to driver if slb_eq2t_en='1' | R/W | 0 |
| 4 | TDRV_PRE_EN | 1 = Tx driver pre-emphasis enable 0 = Tx driver pre-emphasis disable. | R/W | 0 |
| 3:2 | RTERM_TX [1:0] | Tx resistor termination select. Disabled when PCI Express feature is enabled 00 = 50 ohm (default) 01 = 75 ohm 10 = 5K ohm | R/W | 2'b00 |
| 1 | RATE_MODE_TX | 0 = Full rate selection for transmit 1 = Half rate selection for transmit | R/W | 0 |
| 0 | tpwddb | 0 = Power down transmit channel 1 = Power up transmit channel | R/W | 0 |

1. For LatticeECP2M-20/50/70/100.

Table 8-80. SERDES Control Register 4 (CH_0B)

| Bit | Name | Description | R/W | Default |
|---|--------------------|---|-----|---------|
| TDRV_AMP Setting for LatticeECP2M-35 | | | | |
| 7:6 | TDRV_AMP[4:3] | See Table 8-81. | R/W | 0 |
| 7:5 | Reserved | For LatticeECP2M-35 only | | |
| 4 | oob_en | 1=Enables boundary scan input path for routing the high speed receive inputs to a lower speed SERDES in the FPGA (for out of band application). | R/W | 0 |
| 3:2 | rx_refck_sel [1:0] | Rx CDR Reference Clock Select 00 = refclk (differential input) 01 = core_xrefclk 1x = reserved | R/W | 2'b00 |
| 1 | RATE_MODE_RX | 0 = Full rate selection for receive 1 = Half rate selection for receive | R/W | 0 |
| 0 | rpwddb | 0 = Power down receive channel. 1 = Power up receive channel | R/W | 0 |

Table 8-81. TDRV_AMP Setting for LatticeECP2M-20/50/70/100

| Bit | Name | Description | | | R/W | Default |
|-------------|---------------|--------------------------------------|----------------------------------|-----------|-----|---------|
| CH_0B [7:6] | TDRV_AMP[4:3] | Tx_driver pre-emphasis level setting | | | R/W | 0 |
| CH_09 [7:5] | TDRV_AMP[2:0] | 3-bit setting in GUI | 5-bit setting in register | mV | | |
| | | 0 | 00101 | 990 | | |
| | | 1 | 00001 | 1250 | | |
| | | 2 | 00010 | 1300 | | |
| | | 3 | 00011 | 1350 | | |
| | | 4 | 11100 | 610 | | |
| | | 5 | 10100 | 730 | | |
| | | 6 | 10110 | 820 | | |
| | | 7 | 01110 | 940 | | |

Table 8-82. SERDES Interrupt Control Register 1 (CH_0C)

| Bit | Name | Description | R/W | Default |
|-----|----------------------|---|-----|---------|
| 7 | Reserved | | | |
| 6 | pci_det_done_int_ctl | 1 = Enable interrupt for detection of far-end receiver for PCI Express | R/W | 0 |
| 5 | rlos_lo_int_ctl | 1 = Enable interrupt for Rx Loss of Signal when input levels fall below the programmed LOW threshold (using rlos_lset) | RW | 0 |
| 4 | ~rlos_lo_int_ctl | 1 = Enable interrupt for receiver Rx Loss of Signal when input level meets or is greater than programmed LOW threshold | RW | 0 |
| 3 | rlos_hi_int_ctl | 1 = Enable interrupt for Rx Loss of Signal when input levels fall below the programmed HIGH threshold (using rlos_hset) | RW | 0 |
| 2 | ~rlos_hi_int_ctl | 1 = Enable interrupt for Rx Loss of Signal when input level meets or is greater than programmed HIGH threshold | RW | 0 |
| 1 | rlol_int_ctl | 1 = Enable interrupt for receiver loss of lock | R/W | 0 |
| 0 | ~rlol_int_ctl | 1 = Enable interrupt when receiver recovers from loss of lock | R/W | 0 |

Per Channel PCS Status Register Details

Table 8-83. PCS Status Register 1 (CH_20)

| Bit | Name | Description | R/W | Int? |
|-----|------------------|--|-----|------|
| 7:5 | Reserved | | | |
| 4 | pfifo_error | 1 = Parallel FIFO error 0 = No Parallel FIFO error | RO | Y |
| 3 | cc_underrun | 1 = CC FIFO underrun 0 = CC FIFO not underrun | RO | Y |
| 2 | cc_overrun | 1 = CC FIFO overrun 0 = CC FIFO not overrun | RO | Y |
| 1 | fb_rx_fifo_error | 1 = FPGA bridge (FB) Rx FIFO overrun 0 = FB Rx FIFO not overrun | RO | Y |
| 0 | fb_tx_fifo_error | 1 = FPGA bridge (FB) Tx FIFO overrun 0 = FB Tx FIFO not overrun | RO | Y |

Table 8-84. PCS Status Register 2 (CH_21)

| Bit | Name | Description | R/W | Int? |
|-----|-------------|---|----------|------|
| 7:0 | prbs_errors | Count of the number of PRBS errors. Clears to zero on read. Sticks at FF. | RO CR | N |

Table 8-85. PCS Status Register 3 (CH_22)

| Bit | Name | Description | R/W | Int? |
|-----|----------|-------------|-----|------|
| 7:0 | Reserved | | | |

Table 8-86. PCS General Interrupt Status Register 4 (CH_23)

| Bit | Name | Description | R/W | Int? |
|-----|----------------------|---|----------|------|
| 7:4 | Reserved | | | |
| 3 | cc_underrun_int | 1 = Interrupt generated on cc_underrun 0 = Interrupt not generated on cc_underrun | RO CR | Y |
| 2 | cc_overnun_int | 1 = Interrupt generated on cc_overnun 0 = Interrupt not generated on cc_overnun | RO CR | Y |
| 1 | fb_rx_fifo_error_int | 1 = Interrupt generated on fb_rx_fifo_error. 0 = Interrupt not generated fb_rx_fifo_error. | RO CR | Y |
| 0 | fb_tx_fifo_error_int | 1 = Interrupt generated on fb_tx_fifo_error. 0 = Interrupt not generated fb_tx_fifo_error. | RO CR | Y |

Table 8-87. PCS Status Register 5 (CH_24)

| Bit | Name | Description | R/W | Int? |
|-----|--------------------|---|-----|------|
| 7 | Reserved | | | |
| 6 | ffs_ls_sync_status | 1 = Sync in the link state machine. 0 = Not sync in the LSM. | RO | N |
| 5 | fb_rxrst_o | 1 = Normal operation 0 = FPGA bridge Rx reset | RO | N |
| 4 | fb_txrst_o | 1 = Normal operation 0 = FPGA bridge Tx reset | RO | N |
| 3 | Reserved | | | |
| 2 | Reserved | | | |
| 1 | cc_re_o | 1 = Elastic FIFO read enable 0 = Elastic FIFO read disable | RO | N |
| 0 | cc_we_o | 1 = Elastic FIFO write enable 0 = Elastic FIFO write disable | RO | N |

Table 8-88. PCS Status Register 6 (CH_25)

| Bit | Name | Description | R/W | Int? |
|-----|----------|-------------|-----|------|
| 7:0 | Reserved | | | |

Per Channel SERDES Status Register Details

Table 8-89. SERDES Status Register 1 (CH_26)

| Bit | Name | Description | R/W | Int? |
|-----|--------------|--|----------|------|
| 7 | Reserved | | | |
| 6 | pci_det_done | 1 = Receiver detection process completed by SERDES transmitter. 0 = Receiver detection process not completed by SERDES transmitter. | RO CR | Y |
| 5 | rlos_lo | 1= Indicates that the input signal detected by receiver is below the programmed LOW threshold | RO CR | Y |
| 4 | ~rlos_lo | 1= Indicates that the input signal detected by receiver is greater than or equal to the programmed LOW threshold | RO CR | Y |
| 3 | rlos_hi | 1= Indicates that the input signal detected by receiver is below the programmed HIGH threshold | RO CR | Y |
| 2 | ~rlos_hi | 1= Indicates that the input signal detected by receiver is greater than or equal to the programmed HIGH threshold | RO CR | Y |
| 1 | rlol | 1=Indicates CDR loss of lock to data. CDR is locked to reference clock. | RO | Y |
| 0 | ~rlol | 1 = Indicates that CDR has locked to data. | RO | Y |

Table 8-90. SERDES Status Register 2 (CH_27)

| Bit | Name | Description | R/W | Int? |
|-----|----------------|---|-----|------|
| 7 | DCO_CALIB_ERR | 1 = indicates DCO calibration might be wrong (L/H boundary band selected) | RO | N |
| 6 | DCO_CALIB_DONE | 1 = indicates DCO calibration done | RO | N |
| 5 | DCO_FACQ_ERR | 1 = indicates DCO frequency acquisition error (>300ppm) | RO | N |
| 4 | DCO_FACQ_DONE | 1 = indicates DCO frequency acquisition done | RO | N |
| 3:1 | Reserved | | | |
| 0 | pci_connect | 1 = Receiver detected by SERDES transmitter (at the transmitter device). 0 = Receiver not detected by SERDES transmitter (at the transmitter device). | RO | N |

Table 8-91. SERDES Status Register 3 (CH_28)

| Bit | Name | Description | R/W | Int? |
|-----|-----------------|-----------------|-----|------|
| 7:0 | DCO_STATUS[7:0] | setdcoidac[7:0] | RO | N |

Table 8-92. SERDES Status Register 4 (CH_29)

| Bit | Name | Description | R/W | Int? |
|-----|------------------|--|-----|------|
| 7:0 | DCO_STATUS[15:8] | [1:0] = setdcoidac[9:8] [7:2] = setdcoband[5:0] | RO | N |

Table 8-93. SERDES Interrupt Status Register 5 (CH_2A)

| Bit | Name | Description | R/W | Int? |
|-----|------------------|--|----------|------|
| 7 | Reserved | | | |
| 6 | pci_det_done_int | 1 = Interrupt generated for pci_det_done | RO CR | Y |
| 5 | rlos_lo_int | 1 = Interrupt generated for rlos_lo | RO CR | Y |
| 4 | ~rlos_lo_int | 1 = Interrupt generated for ~rlos_lo | RO CR | Y |
| 3 | rlos_hi_int | 1 = Interrupt generated for rlos_hi | CO CR | Y |
| 2 | ~rlos_hi_int | 1 = Interrupt generated for ~rlos_hi | CO CR | Y |
| 1 | rlol_int | 1 = Interrupt generated for rlol | CO CR | Y |
| 0 | ~rlol_int | 1 = Interrupt generated for ~rlol | CO CR | Y |

Table 8-94. SERDES Status Register 6 (CH_2B)

| Bit | Name | Description | R/W | Default |
|-----|----------|-------------|-----|---------|
| 7:0 | Reserved | | | |

Table 8-95. SERDES Status Register 7 (CH_2C)

| Bit | Name | Description | R/W | Default |
|-----|----------|-------------|-----|---------|
| 7:0 | Reserved | | | |

Table 8-96. K Characters Recognized for Different Standards

| Character | Gbe | XAUI | 1xFC | PCI Express | RapidIO |
|------------|--------------------------|---------|--------------------------------------|-------------------------------|-----------|
| K23.7 (F7) | Carrier extend | | | PAD | |
| K27.7 (FB) | SOP | ST | | Start TLP | A (align) |
| K28.0 (1C) | | SKIP R | | SKIP | SC |
| K28.1 (3C) | | | | FTS | |
| K28.2 (5C) | | SoS | | Start DLLP | |
| K28.3 (7C) | | ALIGN A | | IDLE | PD |
| K28.4 (9C) | | SEQ | | | |
| K28.5 (BC) | +D5.6 or D16.2 = IDLE | SYNC K | +D21.4 +D21.5 +D21.5 = IDLE | COMMA (used for alignment) | K |
| K28.6 (DC) | | | | | |
| K28.7 (FC) | | | | | |
| K29.7 (FD) | EOP | T | | END | R (skip) |
| K30.7 (FE) | ERR | ERR | | END BAD | |

Note: Refer to each standard specification for detailed information.

Appendix B. 8b10b Symbol Codes

Table 8-97. 8b10b Symbol Codes

| Symbol Name (Mode Combination Table) | Symbol Code (8b10b Code) | 10-Bit GUI Representation |
|---|-----------------------------|------------------------------|
| K28.0 | 8`b000_11100 | 0100011100 |
| K28.5 | 8`b101_11100 | 0110111100 |
| K29.7 | 8`b111_11101 | 0011111101 |
| D16.2 | 8`b010_10000 | 0001010000 |
| D21.4 | 8`b100_10101 | 0010010101 |
| D21.5 | 8`b101_10101 | 0010110101 |
| K28.5+ | 10`b110000_0101 | 1100000101 |
| K28.5- | 10`b001111_1010 | 0011111010 |

Table 8-98. Lattice Mask for Symbol Code

| Symbol Name (Mode Combination Table) | Symbol Code (8b10b Code) | 10-Bit GUI Representation |
|---|--------------------------|---------------------------|
| 28.5 (Mask) | 10`b111111_1111 | 1111111111 |

Appendix C. Attribute Cross-Reference Table

Table 8-99. Attribute Cross-Reference Table

| Independent Attribute Name | Dependent Attribute Names | Attribute Value | Register Map ³ |
|----------------------------------|---|---|--|
| PROTOCOL | [QAUD_MODE, CHn_RX_DET, CHn_OOB_EN, CHn_GE_AN_EN] | GIGE : [00000,00,0,1] PCIE : [00100,00.0,0] G8B10B : [00001,00,0,0] 10BSER : [00001,00,0,0] 8BSER : [00001,00,0,0] SDSDI : [00001,00,1,0] HSDSI : [00001,00,0,0] | {QD_00 [4:0] , CH_01 [5:4] , CH_0B [4] , CH_00 [4] } |
| CH[0,1,2,3]_MODE | [CHn_TXPWDNB, CHn_RXPWDNB] | SINGLE : [11] GROUP1 : [11] GROUP2 : [11] DISABLE: [00] | {CH_0A [0] , CH_0B [0] } |
| DATARANGE (ECP2M35 ES Device) | [PLL_DIV, CHn_CDR_DIV] | LOW : [101,101] MEDLOW : [100,100] MED : [010,010] MEDHIGH : [010,000] HIGH : [000,000] | {QD_14 [2:0] , CH_07 [2:0] } |
| DATARANGE (All other Devices) | | LOW : [101,101] MEDLOW : [100,100] MED : [010,010] MEDHIGH : [000,000] HIGH : [000,000] | |
| CH[0,1,2,3]_REFCK_MULT | [BUS8BIT_SEL, REFCK25X, REFCK_MODE, CHn_RATE_MODE_RX, CHn_RATE_MODE_TX] | 8X : [1,0,1,0,0] 8XH : [1,0,1,1,1] 10X : [0,0,1,0,0] 10XH : [0,0,1,1,1] 16X : [1,0,0,0,0] 16XH : [1,0,0,1,1] 20X : [0,0,0,0,0] 20XH : [0,0,0,1,1] 25X : [0,1,0,0,0] 25XH : [0,1,0,1,1] | {QD_12 [6] , QD_12 [7] , QD_13 [6] , CH_0B [1] , CH_0A [1] } |
| CH[0,1,2,3]_DATA_WIDTH | [TXCLKF, TXCLKH, CHn_RXCLKF, CHn_RXCLKH, CHn_TX_GEAR, CHn_RX_GEAR, CHn_BUS_WIDTH8] | 8, BYPASS : [0,1,0000,0000,0,0,1] 8, NORMAL; 10, BYPASS; 10, NORMAL : [0,1,0000.0000,0,0,0] 16, BYPASS : [01,1111,1111,1,1,1] 16, NORMAL; 20, BYPASS; 20, NORMAL : [0,1,1111,1111,1,1,0] | {QD_1B [7] , QD_1B [6] , QD_1A [7:4] , QD_1A [3:0] , CH_01 [2] , CH_01 [3] , CH_02 [7] } |
| PLL_SRC | | REFCLK : [0] CORE_TXREFCLK : [1] | {QD_11 [5] } |
| CH[0,1,2,3]_CDR_SRC | | REFCLK : [00] CORE_RXREFCLK : [01] | {CH_0B [3:2] } |

Table 8-99. Attribute Cross-Reference Table (Continued)

| Independent Attribute Name | Dependent Attribute Names | Attribute Value | Register Map ³ |
|---|---|---|---|
| CH_[0,1,2,3]_TRDV_AMP (ECP2M35 all Device) | | 0: [000] 1: [001] 2: [010] 3: [011] 4: [100] 5: [101] 6: [110] 7: [111] | CH_09 [7:5] |
| CH_[0,1,2,3]_TRDV_AMP (All other Devices) | | 0: [00101] 1: [00001] 2: [00010] 3: [00011] 4: [11100] 5: [10100] 6: [10110] 7: [01110] | CH_0B [7:6] CH_09 [7:5] |
| CH_[0,1,2,3]_TX_PRE ⁵ (ECP2M35 ES Device) | [CHn_TRDV_PRE_EN, CHn_TRDV_PRE_SET] | DISABLE: [0,000] 0: [1,000] 1: [1,001] 2: [1,010] 3: [1,011] 4: [1,100] 5: [1,101] | {CH_0A [4], CH_09 [4:2]} |
| CH_[0,1,2,3]_TX_PRE ⁶ (ECP2M35 non-ES device) | | DISABLE: [0,000] 0: [1,000] 1: [1,001] 2: [1,010] 3: [1,011] 4: [1,100] 5: [1,101] 6: [1,110] | |
| CH_[0,1,2,3]_TX_PRE ⁶ (All other Devices) | | DISABLE: [0,00000] 0: [1,00000] 1: [1,00001] 2: [1,00010] 3: [1,01010] 4: [1,10010] 5: [1,00011] 6: [1,00100] | {CH_0A [4], CH_09 [4:0]} |
| CH[0,1,2,3]_RTERM_TX | | 50: [00] 75: [01] 5K: [10] | {CH_0A [3:2]} |
| CH[0,1,2,3]_RX_EQ | [CHn_REQ_EN, CHn_REQ_LVL_SET, CHn_RATE_SEL] | DISABLE : [0,0,00] MID_LOW : [1,0,10] MID_MED : [1,0,01] MID_HIGH : [1,0,00] LONG_LOW : [1,1,10] LONG_MED : [1,1,01] LONG_HIGH : [1,1,00] | {CH_07 [7], CH_07 [6], CH_07 [4:3]} |
| CH[0,1,2,3]_RTERM_RX | [CHn_RX_RTERM] | 50 : [00] 60 : [11] 75 : [01] HIGH ⁴ : [10] | {CH_08 [1:0]} |
| CH[0,1,2,3]_RX_DCC | | AC: [0] DC: [1] | {CH_07 [5]} |

Table 8-99. Attribute Cross-Reference Table (Continued)

| Independent Attribute Name | Dependent Attribute Names | Attribute Value | Register Map ³ |
|--------------------------------------|--|--|---|
| LOS_THRESHOLD (ECP2M35 ES device) | [RLOS_LO, RLOS_HI] | 0: [000,000] 1: [001,000] 2: [010,000] 3: [011,000] 4: [100,000] 5: [101,000] 6: [110,000] 7: [111,000] | {QD_12 [2:0], QD_12 [5:3]} |
| LOS_THRESHOLD (All other devices) | [LOS_HI_SEL, RLOS_LO, RLOS_HI] | 0: [1111,000,000] 1: [1111,000,001] 2: [1111,000,010] 3: [1111,000,011] 4: [1111,000,100] 5: [1111,000,101] 6: [1111,000,110] 7: [1111,000,111] | {CH_05 [0], QD_12 [2:0], QD_12 [5:3]} |
| PLL_TERM | | 50: [0] 2K: [1] | {QD_11 [3]} |
| PLL_DCC | | AC: [0] DC: [1] | {QD_11 [4]} |
| PLL_LOL_SET | | 0: [00] 1: [01] 2: [10] 3: [11] | {QD_14 [4:3]} |
| CH[0,1,2,3]_TX_SB | [CHn_TXPOL, CHn_TXSBBYP] | NORMAL: [0,0] INV : [1,0] | {CH_00 [1], CH_02 [6]} |
| CH[0,1,2,3]_RX_SB | [CHn_RXPOL, CHn_RXWSBBYP] | NORMAL: [0,0] INV : [1,0] | {CH_00 [0], CH_03 [1]} |
| CH[0,1,2,3]_8B10B | [CHn_TXENC, CHn_RXDEC] | NORMAL: [0,0] BYPASS: [1,1] | {CH_02 [3], CH_03 [3]} |
| COMMA_A | | Note 1 | {QD_0A [0:7], QD_0C [6:7]} |
| COMMA_B | | Note 1 | {QD_0B [0:7], QD_0C [4:5]} |
| COMMA_M | | Note 1 | {QD_09 [0:7], QD_0C [2:3]} |
| CH[0,1,2,3]_COMMA_ALIGN | [CHn_RXWA, CHn_LSM_SEL, CHn_C_ALIGN, CHn_SIG_DET] | AUTO : [0,0,0,1] DYNAMIC : [0,1,0,0] BYPASS : [1,1,0,0] | {CH_03 [2], CH_03 [7], CH_00 [7], CH_03 [6]} |
| CH[0,1,2,3]_CTC_BYP | [CHn_RXRECCLK] | NORMAL : [0,0,0,0,0] BYPASS : [1,1,1,1,1] | {QD_19 [3:0], CH_03 [4]} |
| CC_MATCH1 | | | {QD_04 [7:0], QD_08 [1:0]} |
| CC_MATCH2 | | | {QD_05 [7:0], QD_08 [3:2]} |
| CC_MATCH3 | | | {QD_06 [7:0], QD_08 [5:4]} |
| CC_MATCH4 | | | {QD_07 [7:0], QD_08 [7:6]} |
| CC_MATCH_MODE | [MATCH_2_EN, MATCH_4_EN] | MATCH_3_4 : [1,0] MATCH_4 : [0,0] MATCH_1_2_3_4 : [0,1] | {QD_03 [4], QD_03 [5]} |

Table 8-99. Attribute Cross-Reference Table (Continued)

| Independent Attribute Name | Dependent Attribute Names | Attribute Value | Register Map ³ |
|----------------------------|-------------------------------------|---|-----------------------------|
| CC_MIN_IPG | | 0: [00] 1: [01] 2: [10] 3: [11] | {QD_03 [7:6]} |
| CCHMARK | | 0: [0000] 1: [0001] 2: [0010] 3: [0011] 4: [0100] 5: [0101] 6: [0110] 7: [0111] 8: [1000] 9: [1001] 10: [1010] 11: [1011] 12: [1100] 13: [1101] 14: [1110] 15: [1111] | {QD_02 [7:4]} |
| CCLMARK | | 0: [0000] 1: [0001] 2: [0010] 3: [0011] 4: [0100] 5: [0101] 6: [0110] 7: [0111] 8: [1000] 9: [1001] 10: [1010] 11: [1011] 12: [1100] 13: [1101] 14: [1110] 15: [1111] | {QD_02 [3:0]} |
| {PLL_SRC, CHn_CDR_SRC} | [REFCKLOCAL] | [CORE_TXREFCLK, CORE_RXREFCLK, CORE_RXREFCLK, CORE_RXREFCLK, CORE_RXREFCLK] : [1] [REFCLK,X,X,X,X] : [0] note2 [X,REFCLK,X,X,X] : [0] [X,X,REFCLK,X,X] : [0] [X,X,X,REFCLK,X] : [0] [X,X,X,X,REFCLK] : [0] | {QD_11 [0]} |
| OS_SSLB | [CHn_EQ2T_EN] | 0: [0] 1: [1] | {CH_08 [5]} |
| OS_SPLBPORTS | [PFIFO_CLR_SEL, CHn_SB_PFIFO_LP] | 0: [0, 0] 1: [1, 1] | {QD_03 [2], CH_02 [5]} |
| OS_PCSLBPORTS | [FB_LOOPBACK] | 0: [0] 1: [1] | {CH_02 [0]} |
| OS_REFCK2CORE | [REFCK2CORE] | 0: [0] 1: [1] | {QD_11 [1]} |
| OS_PLLQCLKPORTS | [TXCLKQ, CHn_RXCLKQ] | 0: [0, 0000] 1: [1, 1111] | {QD_QB [5], QD_1B [3:0]} |

Table 8-99. Attribute Cross-Reference Table (Continued)

| Independent Attribute Name | Dependent Attribute Names | Attribute Value | Register Map ³ |
|----------------------------|--|--|--|
| OS_INT_ALL | [PLOL_INT, PLOLN_INT, CHn_PCIDETINT, CHn_RLOSLINT, CHn_RLOSLNINT, CHn_RLOSHINT, CHn_RLOSHNINT, CHn-RLOLINT, CHn_RLOLNINT, CHn_LSSYNCINT, CHn_LSSYNCNINT, CHn_TXFIFOINT, CHn_RXFIFOINT, CHn_CCORUNINT, CHn_CCURUNINT] | 0: [0,0,0,0,0,0,0,0,0,0,0000, 0000,0,0,0,0] 1: [1,1,1,1,1,1,1,1,1,1,1111, 1111,1,1,1,1] | {QD_16 [7] , QD_16 [6] , QD_0C [1] , QD_0C [2] , QD_0C [3] , QD_0C [4] , QD_0C [5] , QD_0C [6] , QD_0C [7] , QD_10 [7:4] , QD_10 [3:0] , CH_04 [0] , CH_04 [1] , CH_04 [2] , CH_04 [3] } |

1. 10-bit symbol code default value or specified by user in the 'PCS Advanced setup' configuration GUI. Since the 10-bit symbol code representation in the GUI is LSB to MSB, the bit representation is swapped appropriately in the table.
2. X = Don't care.
3. QD_xx : Quad Register with Base Address = xx
CH_yy : Channel Register with Base Address = yy
4. HIGH = 2K for LatticeECP2M35 ES devices and infinity for all other devices.
5. 0: 0%; 1: 16%; 2: 32%; 3:48%; 4:64%; 5:80%.
6. 0: 0%; 1: 16%; 2: 36%; 3:40%; 4:44%; 5:56%; 6:80%.

Appendix D. Protocol Specific SERDES Setup Options

Table 8-100. Protocol Specific SERDES Setup Options

| Protocol | DATARATE | DATARATE Range | REFCK Multiplier | DATA WIDTH | Rx Equalization ¹ |
|--------------------|-----------|---|------------------|------------|--|
| GbE | 1.25 | MED | 20x, 10x, 5x | 8, 16 | DISABLE, MID_MED, LONG_MED |
| PCI Express | 2.5 | HIGH | 25x, 20x | | DISABLE, MID_HIGH, LONG_HIGH |
| XAUI | 3.125 | HIGH | 20x | 16 | |
| Generic 8b10b | ANY_VALUE | LOW, MEDLOW, MED, MEDHIGH, HIGH | 20x, 10x, 5x | 8, 16 | DISABLE, MID_LOW, MID_MED, MID_HIGH, LONG_LOW, LONG_MED, LONG_HIGH |
| 8-bit SERDES_Only | | | 16x, 8x, 4x | | |
| 10-bit SERDES_Only | | | 20x, 10x, 5x | 10, 20 | |

1. MID: about 20" in length
 LONG: about 40" in length
 LOW: less than 1.2 Gbps
 MED: between 1.2 Gbps and 2 Gbps
 HIGH: over 2 Gbps

Appendix E. Lattice Diamond Usage Overview

This appendix discusses the use of Lattice Diamond design software for projects that include the LatticeECP2M SERDES/PCS module .

For general information about the use of Lattice Diamond, refer to the Lattice Diamond Tutorial.

If you have been using ispLEVER software for your FPGA design projects, Lattice Diamond may look like a big change. But if you look closer, you will find many similarities because Lattice Diamond is based on the same toolset and work flow as ispLEVER. The changes are intended to provide a simpler, more integrated, and more enhanced user interface.

Converting an ispLEVER Project to Lattice Diamond

Design projects created in ispLEVER can easily be imported into Lattice Diamond. The process is automatic except for the ispLEVER process properties, which are similar to the Diamond strategy settings, and PCS modules. After importing a project, you need to set up a strategy for it and regenerate any PCS modules.

Importing an ispLEVER Design Project

Make a backup copy of the ispLEVER project or make a new copy that will become the Diamond project.


1. In Diamond, choose **File > Open > Import ispLEVER Project**.
2. In the ispLEVER Project dialog box, browse to the project's .syn file and open it.
3. If desired, change the base file name or location for the Diamond project. If you change the location, the new Diamond files will go into the new location, but the original source files will not move or be copied. The Diamond project will reference the source files in the original location.

The project files are converted to Diamond format with the default strategy settings.

Adjusting PCS Modules

PCS modules created with IPexpress have an unusual file structure and need additional adjustment when importing a project from ispLEVER. There are two ways to do this adjustment. The preferred method is to regenerate the module in Diamond. However this may upgrade the module to a more recent version. An upgrade is usually desirable but if, for some reason, you do not want to upgrade the PCS module, you can manually adjust the module by copying its .txt file into the implementation folder. If you use this method, you must remember to copy the .txt file into any future implementation folders.

Regenerate PCS Modules

1. Find the PCS module in the Input Files folder of File List view. The module may be represented by an .lpc, .v, or .vhd file.
2. If the File List view shows the Verilog or VHDL file for the module, and you want to regenerate the module, import the module's .lpc file:
 - a. In the File List view, right-click the implementation folder () and choose **Add > Existing File**.
 - b. Browse for the module's .lpc file, **<module_name>.lpc**, and select it.
 - c. Click **Add**. The .lpc file is added to the File List view.
 - d. Right-click the module's Verilog or VHDL file and choose **Remove**.
3. In File List, double-click the module's .lpc file. The module's IPexpress dialog box opens.
4. In the bottom of the dialog box, click **Generate**. The Generate Log tab is displayed. Check for errors and close.

In File List, the .lpc file is replaced with an .lpx file. The IPexpress manifest (.lpx) file is new with Diamond. The .lpx file keeps track of the files needed for complex modules.

Using IPexpress with Lattice Diamond

Using IPexpress with Lattice Diamond is essentially same as with ispLEVER.

The configuration GUI tabs are all the same except for the Generation Options tab. Figure 8-48 shows the Generation Options tab window.

Figure 8-48. Generation Options Tab



Table 8-101. SERDES_PCS GUI Attributes – Generation Options Tab

| GUI Text | Description |
|---|---|
| Automatic | Automatically generates the HDL and configuration(.txt) files as needed. Some changes do not require regenerating both files. |
| Force Module and Settings Generation | Generates both the HDL and configuration files. |
| Force Settings Generation Only | Generates only the attributes file. You get an error message if the HDL file also needs to be generated. |
| Force Place & Route Process Reset | Resets the Place & Route Design process, forcing it to be run again with the newly generated PCS module. |
| Force Place & Route Trace Process Reset | Resets the Place & Route Trace process, forcing it to be run again with the newly generated PCS module. |

Note:
Automatic is set as the default option. If either Automatic or Force Settings Generation Only and no sub-options (Process Reset Options) are checked and the HDL module is not generated, the reset pointer is set to Bitstream generation automatically.

After the Generation is finished, the reset marks in the process window will be reset accordingly.

Creating a New Simulation Project Using Simulation Wizard

This section describes how to use the Simulation Wizard to create a simulation project (.spf) file so you can import it into a standalone simulator.

1. In Project Navigator, click **Tools > Simulation Wizard**. The Simulation Wizard opens.
2. In the Preparing the Simulator Interface page click **Next**.
3. In the Simulator Project Name page, enter the name of your project in the Project Name text box and browse to the file path location where you want to put your simulation project using the Project Location text box and Browse button.

When you designate a project name in this wizard page, a corresponding folder will be created in the file path you choose. Click **Yes** in the popup dialog that asks you if you wish to create a new folder.

4. Click either the Active-HDL® or ModelSim® simulator check box and click **Next**.
5. In the Process Stage page choose which type of Process Stage of simulation project you wish to create. Valid types are RTL, Post-Synthesis Gate-Level, Post-Map Gate-Level, and Post-Route Gate-level+Timing. Only those process stages that are available are activated.

Note that you can make a new selection for the current strategy if you have more than one defined in your project.

The software supports multiple strategies per project implementation which allow you to experiment with alternative optimization options across a common set of source files. Since each strategy may have been processed to different stages, this dialog allows you to specify which stage you wish to load.

6. In the Add Source page, select from the source files listed in the Source Files list box or use the browse button on the right to choose another desired source file. Note that if you wish to keep the source files in the local simulation project directory you just created, check the **Copy Source to Simulation Directory** option.
7. Click **Next** and a Summary page appears and provides information on the project selections including the simulation libraries. By default, the Run Simulator check box is enabled and will launch the simulation tool you chose earlier in the wizard in the Simulator Project Name page.
8. Click **Finish**.

The Simulation Wizard Project (.spf) file and a simulation script DO file are generated after running the wizard. You can import the DO file into your current project if desired. If you are using Active-HDL, the wizard will generate an .ado file and if you are using ModelSim, it creates and .mdo file.

Note: PCS configuration file, (.txt) must be added in step 6.

Introduction

The LatticeECP2™ and LatticeECP2M™ sysIO™ buffers give the designer the ability to easily interface with other devices using advanced system I/O standards. This technical note describes the sysIO standards available and how they can be implemented using Lattice’s ispLEVER® design software.

sysIO Buffer Overview

LatticeECP2/M sysIO interface contains multiple Programmable I/O Cells (PIC) blocks. Each PIC contains two Programmable I/Os (PIO), PIOA and PIOB, connected to their respective sysIO Buffers. Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”).

Each Programmable I/O (PIO) includes a sysIO Buffer and I/O Logic (IOLOGIC). The LatticeECP2/M sysIO buffers supports a variety of single-ended and differential signaling standards. The sysIO buffer also supports the DQS strobe signal that is required for interfacing with the DDR memory. One of every 16/18 PIOs in the LatticeECP2/M contains a delay element to facilitate the generation of DQS signals. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. For more information on the architecture of the sysIO buffer please refer to the [LatticeECP2/M Family Data Sheet](#).

The IOLOGIC includes input, output and tristate registers that implement both single data rate (SDR) and double data rate (DDR) applications along with the necessary clock and data selection logic. Programmable delay lines and dedicated logic within the IOLOGIC are used to provide the required shift to incoming clock and data signals and the delay required by DQS inputs in DDR memory. The DDR implementation in the IOLOGIC and the DDR memory interface support are discussed in more detail in TN1105, [LatticeECP2/M High-Speed I/O Interface](#).

Supported sysIO Standards

The LatticeECP2/M sysIO buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into internally ratioed standard such as LVCMOS, LVTTTL and PCI; and externally referenced standards such as HSTL and SSTL. The buffers support the LVTTTL, LVCMOS 1.2, 1.5, 1.8, 2.5 and 3.3V standards. In the LVCMOS and LVTTTL modes, the buffer has individually configurable options for drive strength, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch). Other single-ended standards supported include SSTL and HSTL. Differential standards supported include LVDS, RSDS, BLVDS, LVPECL, differential SSTL and differential HSTL. Tables 1 and 2 list the sysIO standards supported in LatticeECP2/M devices.

Table 9-1. Supported Input Standards

| Input Standard | V _{REF} (Nom.) | V _{CCIO} ¹ (Nom.) |
|--------------------------------|-------------------------|---------------------------------------|
| Single Ended Interfaces | | |
| LVTTTL | — | — |
| LVCMOS33 | — | — |
| LVCMOS25 | — | — |
| LVCMOS18 | — | 1.8 |
| LVCMOS15 | — | 1.5 |
| LVCMOS12 | — | — |
| PCI 33 | — | 3.3 |
| HSTL18 Class I, II | 0.9 | — |
| HSTL15 Class I | 0.75 | — |
| SSTL3 Class I, II | 1.5 | — |

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Table 9-1. Supported Input Standards (Continued)

| Input Standard | V _{REF} (Nom.) | V _{CCIO} ¹ (Nom.) |
|----------------------------------|-------------------------|---------------------------------------|
| SSTL2 Class I, II | 1.25 | — |
| SSTL18 Class I, II | 0.9 | — |
| GTL+ ² | 1.0 | — |
| Differential Interfaces | | |
| Differential SSTL18 Class I, II | — | — |
| Differential SSTL2 Class I, II | — | — |
| Differential SSTL3 Class I, II | — | — |
| Differential HSTL15 Class I | — | — |
| Differential HSTL18 Class I, II | — | — |
| LVDS, MLVDS, LVPECL, BLVDS, RSDS | — | — |

1 When not specified, V_{CCIO} can be set anywhere in the valid operating range.

2. GTL+ inputs can be supported using HSTL15 Class I inputs with VREF set to 1.0V and external VTT termination to 1.5V. Please see “[sysIO Buffer Configurations](#)” on page 6 for implementation details.

Table 9-2. Supported Output Standards

| Output Standard | Drive | V _{CCIO} (Nom.) |
|---------------------------------|----------------------------|--------------------------|
| Single-ended Interfaces | | |
| LVTTTL | 4mA, 8mA, 12mA, 16mA, 20mA | 3.3 |
| LVC MOS33 | 4mA, 8mA, 12mA 16mA, 20mA | 3.3 |
| LVC MOS25 | 4mA, 8mA, 12mA, 16mA, 20mA | 2.5 |
| LVC MOS18 | 4mA, 8mA, 12mA, 16mA | 1.8 |
| LVC MOS15 | 4mA, 8mA | 1.5 |
| LVC MOS12 | 2mA, 6mA | 1.2 |
| LVC MOS33, Open Drain | 4mA, 8mA, 12mA 16mA, 20mA | — |
| LVC MOS25, Open Drain | 4mA, 8mA, 12mA 16mA, 20mA | — |
| LVC MOS18, Open Drain | 4mA, 8mA, 12mA 16mA | — |
| LVC MOS15, Open Drain | 4mA, 8mA | — |
| LVC MOS12, Open Drain | 2mA, 6mA | — |
| PCI33/PCIX | N/A | 3.3 |
| HSTL18 Class I | 8mA, 12mA | 1.8 |
| HSTL18 Class II | N/A | 1.8 |
| HSTL15 Class I | 4mA, 8mA | 1.5 |
| SSTL3 Class I, II | N/A | 3.3 |
| SSTL2 Class I | 8mA, 12mA | 2.5 |
| SSTL2 Class II | 16mA, 20mA | 2.5 |
| SSTL18 Class I | N/A | 1.8 |
| SSTL18 Class II | 8mA, 12mA | 1.8 |
| Differential Interfaces | | |
| Differential SSTL3, Class I, II | N/A | 3.3 |
| Differential SSTL2, Class I | 8mA, 12mA | 2.5 |
| Differential SSTL2, Class II | 16mA, 20mA | 2.5 |
| Differential SSTL18, Class I | N/A | 1.8 |
| Differential SSTL18, Class II | 8mA, 12mA | 1.8 |
| Differential HSTL18, Class I | 8mA, 12mA | 1.8 |

Table 9-2. Supported Output Standards (Continued)

| Output Standard | Drive | V _{CCIO} (Nom.) |
|-------------------------------|----------|--------------------------|
| Differential HSTL18, Class II | N/A | 1.8 |
| Differential HSTL15, Class I | 4mA, 8mA | 1.5 |
| LVDS | N/A | 2.5 |
| MLVDS ¹ | N/A | 2.5 |
| BLVDS ¹ | N/A | 2.5 |
| LVPECL ¹ | N/A | 3.3 |
| RSDS ¹ | N/A | 2.5 |

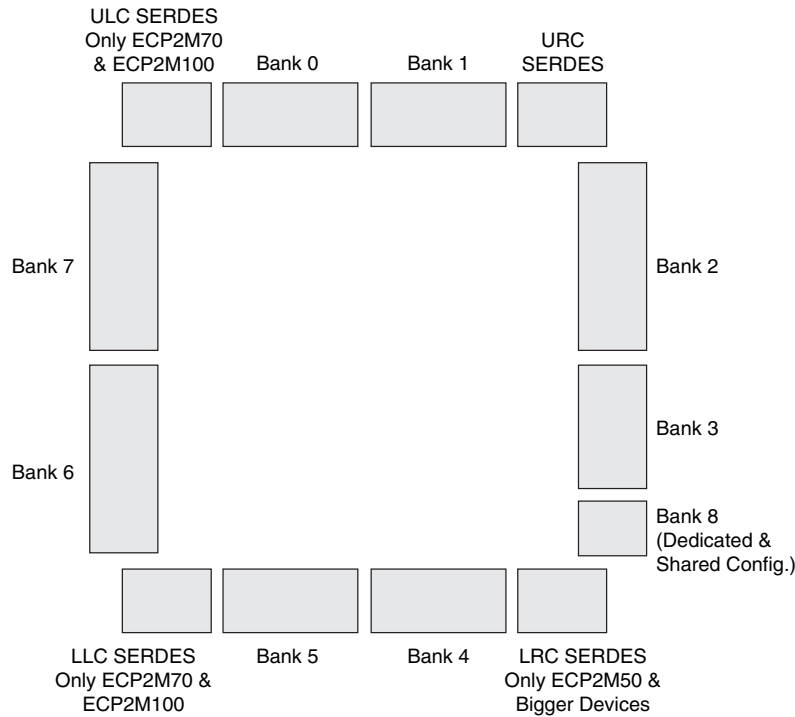
1. Emulated with external resistors.

sysIO Banking Scheme

LatticeECP2/M devices have eight general purpose programmable sysIO banks and a ninth configuration bank. Each of the eight general purpose sysIO banks has a V_{CCIO} supply voltage, and two reference voltages, V_{REF1} and V_{REF2}. Figure 9-1 shows the eight general purpose banks and the configuration bank with associated supplies. Bank 8 is a bank dedicated to configuration logic and has seven dedicated configuration I/Os and 14 multiplexed configuration I/Os. Bank 8 does have the power supply pads (V_{CCIO} and V_{CCAUX}) but does not have any independent V_{REF} pads. The I/Os in Bank 8 are connected to V_{REF} from Bank 3.

On the top and bottom banks, the sysIO buffer pair consists of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The left and right sysIO buffer pair consists of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input. In 50% of the pairs there is also one differential output driver. The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

Figure 9-1. LatticeECP2M sysIO Banking



Note: URC = upper right corner, LRC = lower right corner, ULC = upper left corner and LLC = lower left corner.

V_{CCIO} (1.2V/1.5V/1.8V/2.5V/3.3V)

There are a total of eight V_{CCIO} supplies, V_{CCIO0} - V_{CCIO7}. Each bank has a separate V_{CCIO} supply that powers the single-ended output drivers and the ratioed input buffers such as LVTTTL, LVCMOS, and PCI. LVTTTL, LVCMOS3.3, LVCMOS2.5 and LVCMOS1.2 also have fixed threshold options allowing them to be placed in any bank. The V_{CCIO} voltage applied to the bank determines the ratioed input standards that can be supported in that bank. It is also used to power the differential output drivers. In addition, V_{CCIO8} is used to supply power to the sysCONFIG™ signals.

V_{CCAUX} (3.3V)

In addition to the bank V_{CCIO} supplies, devices have a V_{CC} core logic power supply and a V_{CCAUX} auxiliary supply that powers the differential and referenced input buffers. V_{CCAUX} is used to supply I/O reference voltage requiring 3.3V to satisfy the common-mode range of the drivers and input buffers.

V_{CCJ} (1.2V/1.5V/1.8V/2.5V/3.3V)

The JTAG pins have a separate V_{CCJ} power supply that is independent of the bank V_{CCIO} supplies. V_{CCJ} determines the electrical characteristics of the LVCMOS JTAG pins, both the output high level and the input threshold.

Table 9-3 shows a summary of all the required power supplies.

Table 9-3. Power Supplies

| Power Supply | Description | Value ¹ |
|--------------------|--|--------------------------|
| V _{CC} | Core Power Supply | 1.2V |
| V _{CCIO} | Power Supply for the I/O and Configuration Banks | 1.2V/1.5V/1.8V/2.5V/3.3V |
| V _{CCAUX} | Auxiliary Power Supply | 3.3V |
| V _{CCJ} | Power Supply for JTAG Pins | 1.2V/1.5V/1.8V/2.5V/3.3V |

1. Refer to [LatticeECP2/M Family Data Sheet](#) for recommended min. and max. values.

Input Reference Voltage (V_{REF1}, V_{REF2})

Each bank can support up to two separate V_{REF} input voltages, V_{REF1} and V_{REF2}, that are used to set the threshold for the referenced input buffers. The locations of these V_{REF} pins are pre-determined within the bank. These pins can be used as regular I/Os if the bank does not require a V_{REF} voltage.

V_{REF1} for DDR Memory Interface

When interfacing to DDR memory, the V_{REF1} input must be used as the reference voltage for the DQS and DQ input from the memory. A voltage divider between V_{REF1} and GND is used to generate an on-chip reference voltage that is used by the DQS transition detector circuit. This voltage divider is only present on V_{REF1} it is not available on V_{REF2}. For more information on the DQS transition detect logic and its implementation, please refer to TN1105, [LatticeECP2/M High-Speed I/O Interface](#). DDR1 follows the SSTL25_II signaling specification and DDR2 follows the SSTL18_II signaling specification.

Mixed Voltage Support in a Bank

The LatticeECP2/M sysIO buffer is connected to three parallel ratioed input buffers. These three parallel buffers are connected to V_{CCIO}, V_{CCAUX} and V_{CC}, giving support for thresholds that track with V_{CCIO} as well as fixed thresholds for 3.3V (V_{CCAUX}) and 1.2V (V_{CC}) inputs. This allows the input threshold for ratioed buffers to be assigned on a pin-by-pin basis rather than tracking with V_{CCIO}. This option is available for all 1.2V, 2.5V and 3.3V ratioed inputs and is independent of the bank V_{CCIO} voltage. For example, if the bank V_{CCIO} is 1.8V, it is possible to have 1.2V and 3.3V ratioed input buffers with fixed thresholds, as well as 2.5V ratioed inputs with tracking thresholds.

Prior to device configuration, the ratioed input thresholds always tracks the bank V_{CCIO}. This option only takes effect after configuration. Output standards within a bank are always set by V_{CCIO}. Table 9-4 shows the sysIO standards that can be mixed in the same bank.

Table 9-4. Mixed Voltage Support

| V _{CCIO} | Input sysIO Standards | | | | | Output sysIO Standards | | | | |
|-------------------|-----------------------|------|------|------|------|------------------------|------|------|------|------|
| | 1.2V | 1.5V | 1.8V | 2.5V | 3.3V | 1.2V | 1.5V | 1.8V | 2.5V | 3.3V |
| 1.2V | Yes | | | Yes | Yes | Yes | | | | |
| 1.5V | Yes | Yes | | Yes | Yes | | Yes | | | |
| 1.8V | Yes | | Yes | Yes | Yes | | | Yes | | |
| 2.5V | Yes | | | Yes | Yes | | | | Yes | |
| 3.3V | Yes | | | Yes | Yes | | | | | Yes |

sysIO Standards Supported by Bank*Table 9-5. I/O Standards Supported by Bank*

| Description | Top Side Banks 0-1 | Right Side Banks 2-3 | Bottom Side Banks 4-5 | Left Side Banks 6-7 |
|----------------------------|--|--|--|---|
| I/O Buffers | Single-ended | Single-ended and Differential | Single-ended | Single-ended and Differential |
| Output Standards Supported | LVTTTL LVC MOS33 LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18 Class I, II SSTL25 Class I, II SSTL33 Class I, II HSTL15 Class I HSTL18_I, II SSTL18D Class I, II SSTL25D Class I, II SSTL33D Class I, II HSTL15D Class I HSTL18D Class I, II LVDS25E ¹ LVPECL ¹ BLVDS ¹ RSDS ¹ | LVTTTL LVC MOS33 LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18 Class I, II SSTL25 Class I, II SSTL33 Class I, II HSTL15 Class I HSTL18 Class I, II SSTL18D Class I, II SSTL25D Class I, II SSTL33D Class I, II HSTL15D Class I HSTL18D Class I, II LVDS LVDS25E ¹ LVPECL ¹ BLVDS ¹ RSDS ¹ | LVTTTL LVC MOS33 LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18 Class I, II SSTL2 Class I, II SSTL3 Class I, II HSTL15 Class I HSTL18 Class I, II SSTL18D Class I, II SSTL25D Class I, II, SSTL33D Class I, II HSTL15D Class I HSTL18D Class I, II PCI33 LVDS25E ¹ LVPECL ¹ BLVDS ¹ RSDS ¹ | LVTTTL LVC MOS33 LVC MOS25 LVC MOS18 LVC MOS15 LVC MOS12 SSTL18 Class I, II SSTL2 Class I, II SSTL3 Class I, II HSTL15 Class I, III HSTL18 Class I, II, III SSTL18D Class I, II SSTL25D Class I, II, SSTL33D_I, II HSTL15D Class I HSTL18D Class I, II LVDS LVDS25E ¹ LVPECL ¹ BLVDS ¹ RSDS ¹ |
| Inputs | All Single-ended, Differential | All Single-ended, Differential | All Single-ended, Differential | All Single-ended, Differential |
| Clock Inputs | All Single-ended, Differential | All Single-ended, Differential | All Single-ended, Differential | All Single-ended, Differential |
| PCI Support | PCI33 without clamp | PCI33 without clamp | PCI33 with clamp | PCI33 without clamp PCI33 with clamp (ECP2M) |
| LVDS Output Buffers | | LVDS (3.5mA) Buffers ² | | LVDS (3.5mA) Buffers ² |

1. These differential standards are implemented by using a complementary LVC MOS driver with external resistor pack.

2. Available only on 50% of the I/Os in the bank.

sysIO Buffer Configurations

All LVC MOS buffer have programmable pull, programmable drive and programmable slew configurations that can be set in the software.

Bus Maintenance Circuit

Each pad has a weak pull-up, weak pull-down and weak buskeeper capability. The pull-up and pull-down settings offer a fixed characteristic, which is useful in creating wired logic such as wired ORs. However, current can be slightly higher than other options, depending on the signal state. The bus-keeper option latches the signal in the last driven state, holding it at a valid level with minimal power dissipation. Users can also choose to turn off the bus maintenance circuitry, minimizing power dissipation and input leakage. Note that in this case, it is important to ensure that inputs are driven to a known state to avoid unnecessary power dissipation in the input buffer.

Programmable Drive

Each LVCMOS or LVTTTL, as well as some of the referenced (SSTL and HSTL) output buffers, has a programmable drive strength option. This option can be set for each I/O independently. The drive strength settings available are 2mA, 4mA, 6mA, 8mA, 12mA, 16mA and 20mA. Actual options available vary by the I/O voltage. The user must consider the maximum allowable current per bank and the package thermal limit current when selecting the drive strength. Table 9-6 shows the available drive settings for each out the output standards.

Table 9-6. Programmable Drive Values for Single-ended Buffers

| Single Ended I/O Standards | Programmable Drive (mA) |
|----------------------------|-------------------------|
| HSTL15_I/ HSTL15D_I | 4, 8 |
| HSTL18_I/ HSTL18D_I | 8, 12 |
| SSTL25_I/ SSTL25D_I | 8, 12 |
| SSTL25_II/ SSTL25D_II | 16, 20 |
| SSTL18_II/SSTL18D_II | 8, 12 |
| LVCMOS12 | 2, 6 |
| LVCMOS15 | 4, 8 |
| LVCMOS18 | 4, 8, 12, 16 |
| LVCMOS25 | 4, 8, 12, 16, 20 |
| LVCMOS33 | 4, 8, 12, 16, 20 |
| LVTTTL | 4, 8, 12, 16, 20 |

Programmable Slew Rate

Each LVCMOS or LVTTTL output buffer pin also has a programmable output slew rate control that can be configured for either low noise or high-speed performance. Each I/O pin has an individual slew rate control. This allows designers to specify slew rate control on a pin-by-pin basis. This slew rate control affects both the rising and falling edges.

Open-Drain Control

All LVCMOS and LVTTTL output buffers can be configured to function as open drain outputs. The user can implement an open drain output by turning on the OPENDRAIN attribute in the software.

Differential SSTL and HSTL Support

The single-ended driver associated with the complementary 'C' pad can optionally be driven by the complement of the data that drives the single-ended driver associated with the true pad. This allows a pair of single-ended drivers to be used to drive complementary outputs with the lowest possible skew between the signals. This is used for driving complementary SSTL and HSTL signals (as required by the differential SSTL and HSTL clock inputs on synchronous DRAM and synchronous SRAM devices respectively). This capability is also used in conjunction with off-chip resistors to emulate LVPECL, and BLVDS output drivers.

PCI Support with Programmable PCICLAMP

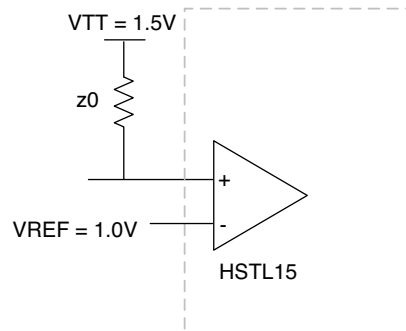
Each sysIO buffer can be configured to support PCI33. The buffers on the bottom of the device (for LatticeECP2) or on the left and bottom sides of the device (for LatticeECP2M) have an optional PCI clamp diode that may optionally be specified in the ispLEVER design tools.

Programmable PCICLAMP can be turned ON or OFF. This option is available on each I/O independently on the bottom side banks (for LatticeECP2) or on the left and bottom side banks (for LatticeECP2M).

GTL+ Input Support

GTL+ inputs are supported using the HSTL15_I input standard with VREF set to 1.0V and external VTT termination set to 1.5V. GTL+ inputs implemented using this method can support the maximum speed listed for the HSTL standard in the [LatticeECP2/M Family Data Sheet](#). GTL+ outputs are not supported in the LatticeECP2 device.

Figure 9-2. GTL+ Input Buffer Emulation Using HSTL15 Input



Programmable Input Delay

Each input can optionally be delayed before it is passed to the core logic or input registers. The primary use for the input delay is to achieve zero hold time for the input registers when using a direct drive primary clock. To arrive at zero hold time, the input delay will delay the data by at least as much as the primary clock injection delay. This option can be turned ON or OFF for each I/O independently in the software using the FIXEDDELAY attribute. This attribute is described in more detail in the software sysIO attribute section. Appendix A shows how this feature can be enabled in the software using HDL attributes.

Software sysIO Attributes

sysIO attributes can be specified in the HDL, using the Preference Editor GUI or in the ASCII preference file (.prf) file directly. Appendices A, B and C list examples of how these can be assigned using each of these methods. This section describes each of these attributes in detail.

IO_TYPE

This is used to set the sysIO standard for an I/O. The V_{CCIO} required to set these I/O standards are embedded in the attribute names itself. There is no separate attribute to set the V_{CCIO} requirements. Table 9-7 lists the available I/O types.

Table 9-7. IO_TYPE Attribute Values

| sysIO Signaling Standard | IO_TYPE |
|-------------------------------------|-----------------------|
| DEFAULT | LVC MOS25 |
| LVDS 2.5V | LVDS25 |
| RS DS | RS DS |
| Emulated LVDS 2.5V | LVDS25E ¹ |
| Bus LVDS 2.5V | BLVDS25 ¹ |
| LVPECL 3.3V | LVPECL33 ¹ |
| HSTL18 Class I and II | HSTL18_I, HTSL18_II |
| Differential HSTL 18 Class I and II | HSTL18D_I, HSTL18D_II |
| HSTL 15 Class I | HSTL15_I |
| Differential HSTL 15 Class I | HSTL15D_I |
| SSTL 33 Class I and II | SSTL33_I, SSTL33_II |
| Differential SSTL 33 Class I and II | SSTL33D_I, SSTL33D_II |
| SSTL 25 Class I and II | SSTL25_I, SSTL25_II |
| Differential SSTL 25 Class I and II | SSTL25D_I, SSTL25D_II |
| SSTL 18 Class I and II | SSTL18_I, SSTL18_II |
| Differential SSTL 18 Class I | SSTL18D_I, SSTL18D_II |
| LV TTL | LV TTL33 |
| 3.3V LVC MOS | LVC MOS33 |
| 2.5V LVC MOS | LVC MOS25 |
| 1.8V LVC MOS | LVC MOS18 |
| 1.5V LVC MOS | LVC MOS15 |
| 1.2V LVC MOS | LVC MOS12 |
| 3.3V PCI | PCI33 |

1. These differential standards are implemented by using a complementary LVC MOS driver with external resistor pack.

OPENDRAIN

LVC MOS and LV TTL I/O standards can be set to open drain configuration by using the OPENDRAIN attribute.

Values: ON, OFF

Default: OFF

DRIVE

The DRIVE attribute will set the programmable drive strength for the output standards that have programmable drive capability

Table 9-8. DRIVE Settings

| Output Standard | DRIVE (mA) | Default (mA) |
|-----------------------|------------------|--------------|
| HSTL15_I/ HSTL15D_I | 4, 8 | 8 |
| HSTL18_I/ HSTL18D_I | 8, 12 | 12 |
| SSTL25_I/ SSTL25D_I | 8, 12 | 8 |
| SSTL25_II/ SSTL25D_II | 16, 20 | 16 |
| SSTL18_II/SSTL18D_II | 8, 12 | 12 |
| LVC MOS12 | 2, 6 | 6 |
| LVC MOS15 | 4, 8 | 8 |
| LVC MOS18 | 4, 8, 12, 16 | 12 |
| LVC MOS25 | 4, 8, 12, 16, 20 | 12 |
| LVC MOS33 | 4, 8, 12, 16, 20 | 12 |
| LV TTL | 4, 8, 12, 16, 20 | 12 |

PULLMODE

The PULLMODE attribute is available for all the LV TTL and LVC MOS inputs and outputs. This attribute can be enabled for each I/O independently.

Values: UP, DOWN, NONE, KEEPER

Default: UP

Table 9-9. PULLMODE Values

| PULL Options | PULLMODE Value |
|-------------------|----------------|
| Pull-up (Default) | UP |
| Pull-down | DOWN |
| Bus Keeper | KEEPER |
| Pull Off | NONE |

PCICLAMP

PCI33 inputs on the bottom of the device (for LatticeECP2) or on the left and bottom sides of the device (for LatticeECP2M) have an optional PCI clamp that is enabled via the PCICLAMP attribute. The PCICLAMP is also available for all LVC MOS33 and LV TTL inputs.

Values: ON, OFF

Default: OFF

Table 9-10. PCICLAMP Values

| Input Type | PCICLAMP Value |
|------------|-------------------|
| PCI33 | ON |
| LVC MOS33 | OFF (default), ON |
| LV TTL | OFF (default), ON |

SLEWRATE

The SLEWRATE attribute is available for all LV TTL and LVC MOS output drivers. Each I/O pin has an individual slew rate control. This allows a designer to specify slew rate control on a pin-by-pin basis.

Values: FAST, SLOW

Default: FAST

FIXEDEDELAY

The **FIXEDEDELAY** attribute is available to each input pin. This attribute, when enabled, is used to achieve zero hold time for the input registers when using global clock. This attribute can only be assigned in the HDL source.

Values: TRUE, FALSE

Default: FALSE

INBUF

By default, all the unused input buffers are disabled. The **INBUF** attribute is used to enable the unused input buffers when performing a boundary scan test. This is a global attribute and can be globally set to ON or OFF.

Values: ON, OFF

Default: OFF

DIN/DOUT

This attribute can be used to assign I/O registers. Using **DIN** will assert an input register and using the **DOUT** attribute will assert an output register. By default, the software will try to assign the I/O registers, if applicable. The user can turn this OFF by using the synthesis attribute or by using the Preference Editor of the ispLEVER software. These attributes can only be applied to registers.

LOC

This attribute can be used to make pin assignments to the I/O ports in the design. This attribute is only used when the pin assignments are made in HDL source. Designers can also assign pins directly using the GUI in the Preference Editor of the ispLEVER software. The appendices explain this in further detail.

Design Considerations and Usage

This section discusses some of the design rules and considerations that must be taken into account when designing with the LatticeECP2/M sysIO buffer

Banking Rules

- If V_{CCIO} or V_{CCJ} for any bank is set to 3.3 V, it is recommended that it be connected to the same power supply as V_{CCAUX} , thus minimizing leakage.
- If V_{CCIO} or V_{CCJ} for any bank is set to 1.2V, it is recommended that it be connected to the same power supply as V_{CC} , thus minimizing leakage.
- When implementing DDR memory interfaces, the V_{REF1} of the bank is used to provide reference to the interface pins and cannot be used to power any other referenced inputs.
- Only the bottom banks for LatticeECP2 (Banks 4 and 5) or left and bottom banks for LatticeECP2M (Banks 4, 5, 6 and 7) will support PCI clamps.
- All legal input buffers should be independent of bank V_{CCIO} , except for 1.8V and 1.5V buffers, which require a bank V_{CCIO} of 1.8V and 1.5V.

Differential I/O Rules

- All banks can support LVDS input buffers. Only the banks on the right and left sides (Banks 2, 3, 6 and 7) will support True Differential output buffers. The banks on the top and bottom will support the LVDS input buffers but will not support True LVDS outputs. The user can use emulated LVDS output buffers on these banks.
- All banks support emulated differential buffers using external resistor pack and complementary LVCMOS drivers.
- Only 50% of the I/Os on the left and right sides can provide LVDS output buffer capability. LVDS can only be assigned to the TRUE pad. The ispLEVER design tool will automatically assign the other I/Os of the differential pair to the complementary pad. Refer to the device data sheet to see the pin listings for all LVDS pairs.

Assigning V_{REF1} / V_{REF2} Groups for Referenced Inputs

Each bank has two dedicated V_{REF} input pins, V_{REF1} and V_{REF2} . Designers can group buffers to a particular V_{REF} rail, V_{REF1} or V_{REF2} . This grouping is done by assigning a PGROUP VREF preference along with the LOCATE PGROUP preference.

Preference Syntax

```
PGROUP <pgrp_name> [(VREF <vref_name>)+] (COMP <comp_name>)+;
LOCATE PGROUP <pgrp_name> BANK <bank_num>;
LOCATE VREF <vref_name> SITE <site_name>;
```

Example Showing VREF Groups

```
PGROUP "vref_pg1" VREF "ref1" COMP "ah(0)" COMP "ah(1)" COMP "ah(2)" COMP "ah(3)"
COMP "ah(4)" COMP "ah(5)" COMP "ah(6)" COMP "ah(7)";
```

```
PGROUP "vref_pg2" VREF "ref2" COMP "al(0)" COMP "al(1)" COMP "al(2)" COMP "al(3)"
COMP "al(4)" COMP "al(5)" COMP "al(6)" COMP "al(7)";
```

```
LOCATE VREF "ref1" SITE PR29C;
LOCATE VREF "ref2" SITE PR48B;
```

or

```
LOCATE PGROUP " vref_pg1" BANK 2;
LOCATE PGROUP " vref_pg2" BANK 2;
```

The example shows two V_{REF} groups, "vref_pg1" assigned to VREF "ref1" and "vref_pg2" assigned to "ref2". The user must lock these V_{REF} to either V_{REF1} or V_{REF2} using the LOCATE preference. Alternatively, users can designate to which bank the V_{REF} group should be located. The software will then assign these to either the V_{REF1} or V_{REF2} of the bank.

If the PGROUP VREF is not used, the software will automatically group all pins that need the same V_{REF} reference voltage. This preference is most useful when there is more than one bus that uses the same reference voltage and the user wishes to associate each of these busses to different V_{REF} resources.

Differential I/O Implementation

The LatticeECP2/M devices support a variety of differential standards as detailed in the following sections.

LVDS

True LVDS (LVDS25) drivers are available on 50% of the I/Os on the left and right side of the devices. LVDS input support is provided on all sides of the device. All four sides of the device support LVDS using complementary LVCMOS drivers with external resistors (LVDS25E). Refer to the [LatticeECP2/M Family Data Sheet](#) for a detailed explanation of these LVDS implementations.

BLVDS

All single-ended sysIO buffers pairs support the Bus-LVDS standard using complementary LVCMOS drivers with external resistors. Please refer to the [LatticeECP2/M Family Data Sheet](#) for a detailed explanation of BLVDS implementation.

RSDS

All single-ended sysIO buffers pairs support RSDS standard using complementary LVCMOS drivers with external resistors. Please refer to the [LatticeECP2/M Family Data Sheet](#) for a detailed explanation of RSDS implementation.

LVPECL

All the sysIO buffers will support LVPECL inputs. LVPECL outputs are supported using complementary LVCMOS driver with external resistors. Please refer to the [LatticeECP2/M Family Data Sheet](#) for a detailed explanation of LVPECL implementation.

Differential SSTL and HSTL

All single-ended sysIO buffers pairs support differential SSTL and HSTL. Please refer to the [LatticeECP2/M Family Data Sheet](#) for a detailed explanation of Differential HSTL and SSTL implementation.

Technical Support Assistance

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Revision History

| Date | Version | Change Summary |
|----------------|---------|--|
| February 2006 | 01.0 | Initial release. |
| September 2006 | 01.1 | Updated to include LatticeECP2M support. |
| April 2007 | 01.2 | Updated Supported Output Standards table. |
| June 2007 | 01.3 | Updated V_{REF1} for DDR Memory Interface section. |
| June 2007 | 01.4 | Updated sysIO Standards Supported by Bank table. Updated Banking Rules bullet list. |
| June 2007 | 01.5 | Updated Power Supplies table. |
| April 2008 | 01.6 | Updated LatticeECP2M sysIO Banking diagram. |
| February 2009 | 01.7 | Updated I/O Standards Supported by Bank table. |
| June 2010 | 01.8 | Updated screen shots in Appendix B. Updated document for Lattice Diamond design software support. |
| March 2011 | 01.9 | Added support for GTL+ input standard using HSTL input buffer. |

Appendix A. HDL Attributes for Synplicity® and Precision® RTL Synthesis

Using these HDL attributes, designers can assign the sysIO attributes directly in their source. The attribute definition and syntax for the appropriate synthesis vendor must be used. Below are a list of all the sysIO attributes, syntax and examples for Precision RTL Synthesis and Synplicity. This section only lists the sysIO buffer attributes for these devices. You can refer to the Precision RTL Synthesis and Synplicity user manuals for a complete list of synthesis attributes. These manuals are available through the ispLEVER software Help system.

VHDL Synplicity/Precision RTL Synthesis

This section lists syntax and examples for all the sysIO Attributes in VHDL when using the Precision RTL Synthesis or Synplicity synthesis tools.

Syntax

Table 9-11. VHDL Attribute Syntax for Synplicity and Precision RTL Synthesis

| Attribute | Syntax |
|-------------|--|
| IO_TYPE | attribute IO_TYPE: string; attribute IO_TYPE of <i>Pinname</i> : signal is " <i>IO_TYPE Value</i> "; |
| OPENDRAIN | attribute OPENDRAIN: string; attribute OPENDRAIN of <i>Pinname</i> : signal is " <i>OpenDrain Value</i> "; |
| DRIVE | attribute DRIVE: string; attribute DRIVE of <i>Pinname</i> : signal is " <i>Drive Value</i> "; |
| PULLMODE | attribute PULLMODE: string; attribute PULLMODE of <i>Pinname</i> : signal is " <i>Pullmode Value</i> "; |
| PCICLAMP | attribute PCICLAMP: string; attribute PCICLAMP of <i>Pinname</i> : signal is " <i>PCIClamp Value</i> "; |
| SLEWRATE | attribute PULLMODE: string; attribute PULLMODE of <i>Pinname</i> : signal is " <i>Slewrates Value</i> "; |
| FIXEDEDELAY | attribute FIXEDDELAY: string; attribute FIXEDDELAY of <i>Pinname</i> : signal is " <i>Fixeddelay Value</i> "; |
| DIN | attribute DIN: string; attribute DIN of <i>Pinname</i> : signal is " "; |
| DOUT | attribute DOUT: string; attribute DOUT of <i>Pinname</i> : signal is " "; |
| LOC | attribute LOC: string; attribute LOC of <i>Pinname</i> : signal is "pin_locations"; |

Examples

IO_TYPE

```
--***Attribute Declaration***
ATTRIBUTE IO_TYPE: string;
--***IO_TYPE assignment for I/O Pin***
ATTRIBUTE IO_TYPE OF portA:    SIGNAL IS "PCI33";
ATTRIBUTE IO_TYPE OF portB:    SIGNAL IS "LVCMOS33";
ATTRIBUTE IO_TYPE OF portC:    SIGNAL IS "LVDS25";
```

OPENDRAIN

```
--***Attribute Declaration***
ATTRIBUTE OPENDRAIN: string;
--***DRIVE assignment for I/O Pin***
ATTRIBUTE OPENDRAIN OF portB: SIGNAL IS "ON";
```

Lattice Semiconductor**DRIVE**

```
--***Attribute Declaration***  
ATTRIBUTE DRIVE: string;  
--***DRIVE assignment for I/O Pin***  
ATTRIBUTE DRIVE OF portB: SIGNAL IS "20";
```

PULLMODE

```
--***Attribute Declaration***  
ATTRIBUTE PULLMODE : string;  
--***PULLMODE assignment for I/O Pin***  
ATTRIBUTE PULLMODE OF portA: SIGNAL IS "DOWN";  
ATTRIBUTE PULLMODE OF portB: SIGNAL IS "UP";
```

PCICLAMP

```
--***Attribute Declaration***  
ATTRIBUTE PCICLAMP: string;  
--***PULLMODE assignment for I/O Pin***  
ATTRIBUTE PCICLAMP OF portA: SIGNAL IS "ON";
```

SLEWRATE

```
--***Attribute Declaration***  
ATTRIBUTE SLEWRATE : string;  
--*** SLEWRATE assignment for I/O Pin***  
ATTRIBUTE SLEWRATE OF portB: SIGNAL IS "FAST";
```

FIXEDEDELAY

```
--***Attribute Declaration***  
ATTRIBUTE FIXEDDELAY: string;  
--*** SLEWRATE assignment for I/O Pin***  
ATTRIBUTE FIXEDDELAY OF portB: SIGNAL IS "TRUE";
```

DIN/DOU

```
--***Attribute Declaration***  
ATTRIBUTE din : string;  
ATTRIBUTE dout : string;  
--*** din/dout assignment for I/O Pin***  
ATTRIBUTE din OF input_vector: SIGNAL IS " ";  
ATTRIBUTE dout OF output_vector: SIGNAL IS " ";
```

LOC

```
--***Attribute Declaration***  
ATTRIBUTE LOC : string;  
--*** LOC assignment for I/O Pin***  
ATTRIBUTE LOC OF input_vector: SIGNAL IS "E3,B3,C3 ";
```

Verilog Synplicity

This section lists syntax and examples for all the sysIO Attributes in Verilog using the Synplicity synthesis tool.

Syntax

Table 9-12. Verilog Synplicity Attribute Syntax

| Attribute | Syntax |
|-----------|---|
| IO_TYPE | <i>PinType PinName</i> /* synthesis IO_TYPE="IO_Type Value"*/; |
| OPENDRAIN | <i>PinType PinName</i> /* synthesis OPENDRAIN ="OpenDrain Value"*/; |
| DRIVE | <i>PinType PinName</i> /* synthesis DRIVE="Drive Value"*/; |
| PULLMODE | <i>PinType PinName</i> /* synthesis PULLMODE="Pullmode Value"*/; |
| PCICLAMP | <i>PinType PinName</i> /* synthesis PCICLAMP =" PCIClamp Value"*/; |
| SLEWRATE | <i>PinType PinName</i> /* synthesis SLEWRATE="Slewrates Value"*/; |
| FIXEDELAY | <i>PinType PinName</i> /* synthesis FIXEDELAY="Fixeddelay Value"*/; |
| DIN | <i>PinType PinName</i> /* synthesis DIN=" "*/; |
| DOUT | <i>PinType PinName</i> /* synthesis DOUT=" "*/; |
| LOC | <i>PinType PinName</i> /* synthesis LOC="pin_locations "*/; |

Examples

```

//IO_TYPE, PULLMODE, SLEWRATE and DRIVE assignment
output portB /*synthesis IO_TYPE="LVCMOS33" PULLMODE ="UP" SLEWRATE ="FAST"
DRIVE ="20"*/;
output portC /*synthesis IO_TYPE="LVDS25" */;

//OPENDRAIN
output portA /*synthesis OPENDRAIN ="ON"*/;

//PCICLAMP
output portA /*synthesis IO_TYPE="PCI33" PULLMODE ="PCICLAMP"*/;

// Fixeddelay
input load /* synthesis FIXEDDELAY="TRUE" */;

// Place the flip-flops near the load input
input load /* synthesis din="" */;

// Place the flip-flops near the outload output
output outload /* synthesis dout="" */;

//I/O pin location
input [3:0] DATA0 /* synthesis loc="E3,B1,F3"*/;

//Register pin location
reg data_in_ch1_buf_reg3 /* synthesis loc="R40C47" */;

//Vectored internal bus
reg [3:0] data_in_ch1_reg /*synthesis loc ="R40C47,R40C46,R40C45,R40C44" */;

```

Verilog Precision

This section lists syntax and examples for all the sysIO Attributes in Verilog using the Precision RTL Synthesis tool.

Syntax

Table 9-13. Verilog Precision Attribute Syntax

| Attribute | Syntax |
|-----------|--|
| IO_TYPE | //pragma attribute <i>PinName</i> IO_TYPE IO_TYPE Value |
| OPENDRAIN | // pragma attribute <i>PinName</i> OPENDRAIN OpenDrain Value |
| DRIVE | // pragma attribute <i>PinName</i> DRIVE Drive Value |
| PULLMODE | // pragma attribute <i>PinName</i> IO_TYPE Pullmode Value |
| PCICLAMP | // pragma attribute <i>PinName</i> PCICLAMP PCIClamp Value |
| SLEWRATE | // pragma attribute <i>PinName</i> IO_TYPE Slewrate Value |
| FIXEDELAY | // pragma attribute <i>PinName</i> IO_TYPE Fixeddelay Value |
| LOC | // pragma attribute <i>PinName</i> LOC pin_location |

Examples

```
//****IO_TYPE ***
//pragma attribute portA IO_TYPE PCI33
//pragma attribute portB IO_TYPE LVCMOS33
//pragma attribute portC IO_TYPE SSTL25_II

//*** Opendrain ***
//pragma attribute portB OPENDRAIN ON
//pragma attribute portD OPENDRAIN OFF

//*** Drive ***
//pragma attribute portB DRIVE 20
//pragma attribute portD DRIVE 8

//*** Pullmode***
//pragma attribute portB PULLMODE UP

//*** PCIClamp***
//pragma attribute portB PCICLAMP ON

//*** Slewrate ***
//pragma attribute portB SLEWRATE FAST
//pragma attribute portD SLEWRATE SLOW

// ***Fixeddelay***
// pragma attribute load FIXEDELAY TRUE

//****LOC***
//pragma attribute portB loc E3
```

Appendix B. sysIO Attributes Using the ispLEVER Design Planner User Interface

Designers can assign sysIO buffer attributes using the Design Planner Spreadsheet View GUI available in the ispLEVER design tool. If you are using Lattice Diamond™ design software, refer to Appendix D. The Pin Attribute Sheet list all the ports in a design and all the available sysIO attributes as preferences. By clicking on each of these cells, a list of all the valid I/O preference for that port is displayed. Each column takes precedence over the next. Therefore, when a particular IO_TYPE is chosen, the DRIVE, PULLMODE and SLEWRATE columns will only list the valid combinations for that IO_TYPE. The pin locations can be locked using the pin location column of the Pin Attribute sheet. Right-clicking on a cell will list the available pin locations. The Preference Editor will also conduct a DRC check to search for any incorrect pin assignments.

Designers can enter DIN/DOUT preferences using the Cell Attributes sheet of the Preference Editor. All the preferences assigned using the Preference Editor are written into the preference file (.prf).

Figures 2 and 3 show the Pin Attribute sheet and the Cell Attribute sheet views of the preference editor. For further information on how to use the Preference Editor, refer to the ispLEVER Help documentation in the Help menu option of the software.

Figure 9-3. Pin Attributes Tab

| | Type | Name | Group by | Pin | Bank | Vref | IO_TYPE | PULLMODE | DRIVE | SLEWRATE | PCICLAMP | OPENDRAIN |
|----|-------------|------|----------|-----|------|------|----------|----------|-------|----------|----------|-----------|
| 1 | Clock Input | clk | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 2 | Input Port | d0_0 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 3 | Input Port | d0_1 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 4 | Input Port | d0_2 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 5 | Input Port | d0_3 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 6 | Input Port | d0_4 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 7 | Input Port | d0_5 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 8 | Input Port | d0_6 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 9 | Input Port | d0_7 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 10 | Input Port | d1_0 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 11 | Input Port | d1_1 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |
| 12 | Input Port | d1_2 | N/A | | | N/A | LVCMOS25 | UP | NA | FAST | OFF | OFF |

Figure 9-4. Cell Attributes Tab

| | Type | Name | Din/Dout | PIO Register |
|----|-----------|---------|----------|--------------|
| 1 | FlipFlops | q_i_7 | DIN | True |
| 2 | FlipFlops | q_reg_0 | DIN | True |
| 3 | FlipFlops | q_reg_1 | DIN | True |
| 4 | FlipFlops | q_reg_2 | DIN | True |
| 5 | FlipFlops | q_reg_3 | DIN | True |
| 6 | FlipFlops | q_reg_4 | DIN | True |
| 7 | FlipFlops | q_reg_5 | DIN | True |
| 8 | FlipFlops | q_reg_6 | DIN | True |
| 9 | FlipFlops | q_reg_7 | DIN | True |
| 10 | FlipFlops | q_i_0 | DIN | True |
| 11 | FlipFlops | q_i_1 | DIN | True |
| 12 | FlipFlops | q_i_2 | DIN | True |
| 13 | FlipFlops | q_i_3 | DIN | True |

Appendix C. sysIO Attributes Using Preference File (ASCII File)

Designers can enter sysIO attributes directly in the preference (.prf) file as sysIO buffer preferences. The PRF file is an ASCII file containing two separate sections: a schematic section for those preferences created by the mapper or translator, and a user section for preferences entered by the user. User preferences can be written directly into this file. The synthesis attributes appear between the schematic start and schematic end of the file. The sysIO buffer preferences can be entered after the schematic end line using the preference file syntax. Below are a list of sysIO buffer preference syntax and examples.

IOBUF

This preference is used to assign the attribute IO_TYPE, PULLMODE, SLEWRATE and DRIVE.

Syntax

```
IOBUF [ALLPORTS | PORT <port_name> | GROUP <group_name>] (keyword=<value>)+;
```

where:

<port_name> = These are not the actual top-level port names, but should be the signal name attached to the port. PIOs in the physical design (.ncd) file are named using this convention. Any multiple listings or wildcarding should be done using GROUPs

Keyword = IO_TYPE, OPENDRAIN, DRIVE, PULLMODE, PCICLAMP, SLEWRATE.

Example

```
IOBUF PORT "port1" IO_TYPE=LVTTL33 OPENDRAIN=ON DRIVE=8 PULLMODE=UP
PCICLAMP =OFF SLEWRATE=FAST;
DEFINE GROUP "bank1" "in*" "out_[0-31]";
IOBUF GROUP "bank1" IO_TYPE=SSTL18_II;
```

LOCATE

When this preference is applied to a specified component, it places the component at a specified site and locks the component to the site. If applied to a specified macro instance, it places the macro's reference component at a specified site, places all of the macro's pre-placed components (that is, all components that were placed in the macro's library file) in sites relative to the reference component, and locks all of these placed components at their sites. This can also be applied to a specified PGROUP.

Syntax

```
LOCATE [COMP <comp_name> | MACRO <macro_name>] SITE <site_name>;
LOCATE PGROUP <pgroup_name> [SITE <site_name>; | REGION <region_name>;]
LOCATE PGROUP <pgroup_name> RANGE <site_1> [<site_2> | <count>] [<direction>] |
RANGE <chip_side> [<direction>];
LOCATE BUS < bus_name> ROW|COL <number>;
<bus_name> := string
<number> := integer
```

Note: If the comp_name, macro_name, or site_name begins with anything other than an alpha character (for example, "11C7"), you must enclose the name in quotes. Wildcard expressions are allowed in <comp_name>.

Examples

This command places the port Clk0 on the site A4:

```
LOCATE COMP "Clk0" SITE "A4";
```

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This command places the component PFU1 on the site named R1C7:

```
LOCATE COMP "PFU1" SITE "R1C7";
```

This command places bus1 on ROW 3 and bus2 on COL4

```
LOCATE BUS "bus1" ROW 3;  
LOCATE BUS "bus2" COL 4;
```

USE DIN CELL

This preference specifies the given register to be used as an input flip-flop.

Syntax

```
USE DIN CELL <cell_name>;
```

where:

```
<cell_name> := string
```

Example

```
USE DIN CELL "din0";
```

USE DOUT CELL

Specifies the given register to be used as an output flip-flop.

Syntax

```
USE DOUT CELL <cell_name>;
```

where:

```
<cell_name> := string
```

Example

```
USE DOUT CELL "dout1";
```

PGROUP VREF

This preference is used to group all the components that need to be associated to one V_{REF} pin within a bank.

Syntax

```
PGROUP <pgrp_name> [(VREF <vref_name>)+] (COMP <comp_name>)+;  
LOCATE PGROUP <pgrp_name> BANK <bank_num>;  
LOCATE VREF <vref_name> SITE <site_name>;
```

Example

```
PGROUP "vref_pg1" VREF "ref1" COMP "ah(0)" COMP "ah(1)" COMP "ah(2)" COMP "ah(3)"  
COMP "ah(4)" COMP "ah(5)" COMP "ah(6)" COMP "ah(7)";  
PGROUP "vref_pg2" VREF "ref2" COMP "al(0)" COMP "al(1)" COMP "al(2)" COMP "al(3)"  
COMP "al(4)" COMP "al(5)" COMP "al(6)" COMP "al(7)";  
LOCATE VREF "ref1" SITE PR29C;  
LOCATE VREF "ref2" SITE PR48B;
```

or:

```
LOCATE PGROUP "vref_pg1" BANK 2;  
LOCATE PGROUP "vref_pg2" BANK 2;
```

Appendix D. Assigning sysIO Attributes Using Lattice Diamond Spreadsheet View

sysIO buffer attributes can be assigned using the Spreadsheet View available in the Lattice Diamond design software. The Port Assignments Sheet lists all the ports in a design and all the available sysIO attributes in multiple columns. Click on each of these cells for a list of all the valid I/O preferences for that port. Each column takes precedence over the next. Therefore, when you choose a particular IO_TYPE, the columns for the DRIVE, PULLMODE, SLEWRATE and other attributes will only list the valid entries for that IO_TYPE.

Pin locations can be locked using the Pin column of the Port Assignments sheet or using the Pin Assignments sheet. You can right-click on a cell and go to Assign Pins to see a list of available pins.

The Spreadsheet View also has an option to run a DRC check to check for any incorrect pin assignments. You can enter the DIN/ DOUT preferences using the Cell Mapping Tab. All the preferences assigned using the Spreadsheet View are written into the logical preference file (.lpf).

Figure 9-5 shows the Port Assignments Sheet of the Spreadsheet View. For further information on how to use the Spreadsheet View, refer to the Diamond Help documentation, available in the Help menu option of the software.

Figure 9-5. Port Attributes Tab of the SpreadSheet View

| | Type | Name | Group by | Pin | Bank | Vref | IO_TYPE | PULLMODE | DRIVE | SLEWRATE | PCICLAMP | OPENDRAIN | Outload |
|----|---------------|------|----------|-----|------|------|-----------|----------|-------|----------|----------|-----------|---------|
| 1 | All Ports | | N/A | N/A | N/A | N/A | LVC MOS25 | UP | N/A | FAST | OFF | OFF | N/A |
| 2 | Input Port | Dir | N/A | | | N/A | LVC MOS25 | UP | NA | FAST | OFF | OFF | N/A |
| 3 | Clock Input | Clk | N/A | | | N/A | LVC MOS25 | UP | NA | FAST | OFF | OFF | N/A |
| 4 | Input Port | Clr | N/A | | | N/A | SSTL18_I | NONE | NA | FAST | OFF | OFF | N/A |
| 5 | Input Port | OE | N/A | | | N/A | LVC MOS25 | UP | NA | FAST | OFF | OFF | N/A |
| 6 | TriState Port | Q_3 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 7 | TriState Port | Q_2 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 8 | TriState Port | Q_1 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 9 | TriState Port | Q_0 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 10 | Bidi Port | A_0 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 11 | Bidi Port | A_1 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 12 | Bidi Port | B_0 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |
| 13 | Bidi Port | B_1 | N/A | | | N/A | LVC MOS25 | UP | 12 | FAST | OFF | OFF | 0.000 |

Users can create a VREF pin using the Spreadsheet View as shown in Figure 9-6 and then assign VREF for a bank using the VREF Column in the Ports Assignment Tab of the Spreadsheet View as shown in Figure 9-7. See the Diamond online help for a detailed description of this setting.

Figure 9-6. Creating a VREF in Spreadsheet View

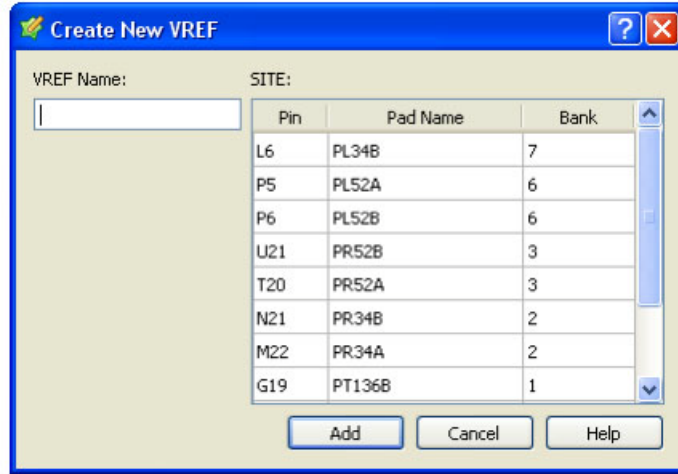


Figure 9-7. Assigning VREF for an Input Port in Spreadsheet View

| Type | Name | Group by | Pin | Bank | Vref | IO_TYPE | PULLMODE | DRIVE | SLEWRATE | PCICLAMP | OPENDRAIN |
|-------------------|------------|----------|-----|------|-----------------|-----------|----------|-------|----------|----------|-----------|
| All Ports | | N/A | N/A | N/A | N/A | LVC MOS25 | UP | N/A | FAST | OFF | OFF |
| Input Port | Dir | N/A | | | N/A | LVC MOS25 | UP | NA | FAST | OFF | OFF |
| Clock Input | Clk | N/A | | | N/A | LVC MOS25 | UP | NA | FAST | OFF | OFF |
| Input Port | Clr | N/A | | | VREF1:L5 | SSTL18_I | NONE | NA | FAST | OFF | OFF |
| Input Port | OE | N/A | | | N/A | LVC MOS25 | UP | NA | FAST | OFF | OFF |

Port Assignments | Pin Assignments | Clock Resource | Route Priority | Cell Mapping | Global Preferences | Timing Preferences | Group | Misc Preferences

Introduction

This user's guide describes the clock resources available in the LatticeECP2™ and LatticeECP2M™ device architectures. Details are provided for primary clocks, secondary clocks and edge clocks, as well as clock elements such as PLLs, DLLs, Clock Dividers and more.

The number of PLLs and DLLs for each package can be found in Tables 10-1 and 10-2.

Table 10-1. Number of PLLs and DLLs: LatticeECP2 Family

| Device | Description | ECP2-6 | ECP2-12 | ECP2-20 | ECP2-35 | ECP2-50 | ECP2-70 |
|-------------------|-------------------------------|--------|---------|---------|---------|---------|---------|
| Number of SPLLS | Standard PLL (Subset of GPLL) | 0 | 0 | 0 | 0 | 2 | 4 |
| Number of GPLLS | General Purpose PLL | 2 | 2 | 2 | 2 | 2 | 2 |
| Number of DLLs | General Purpose DLL | 2 | 2 | 2 | 2 | 2 | 2 |
| Number of DQSDLLs | DLL for DDR Applications | 2 | 2 | 2 | 2 | 2 | 2 |

Table 10-2. Number of PLLs, DLLs and SERDES: LatticeECP2M Family

| Device | Description | ECP2M-20 | ECP2M-35 | ECP2M-50 | ECP2M-70 | ECP2M-100 |
|-------------------|-------------------------------|----------|----------|----------|----------|-----------|
| Number of SPLLS | Standard PLL (Subset of GPLL) | 6 | 6 | 6 | 6 | 6 |
| Number of GPLLS | General Purpose PLL | 2 | 2 | 2 | 2 | 2 |
| Number of DLLs | General Purpose DLL | 2 | 2 | 2 | 2 | 2 |
| Number of DQSDLLs | DLL for DDR Applications | 2 | 2 | 2 | 2 | 2 |
| SERDES | 4-Channel Quad SERDES | 1 | 1 | 2 | 4 | 4 |

Clock/Control Distribution Network

The LatticeECP2/M family provides global clock distribution in the form of eight quadrant-based primary clocks and flexible secondary clocks. The devices also provide two edge clocks on each edge of the device. Other clock sources include clock input pins, internal nodes, PLLs, DLLs, Slave Delay Lines and Clock Dividers.

LatticeECP2/M Top Level View

Figure 10-1 shows the primary clocking structure of the LatticeECP2-50 device.

Figure 10-1. LatticeECP2-50 Clocking Structure

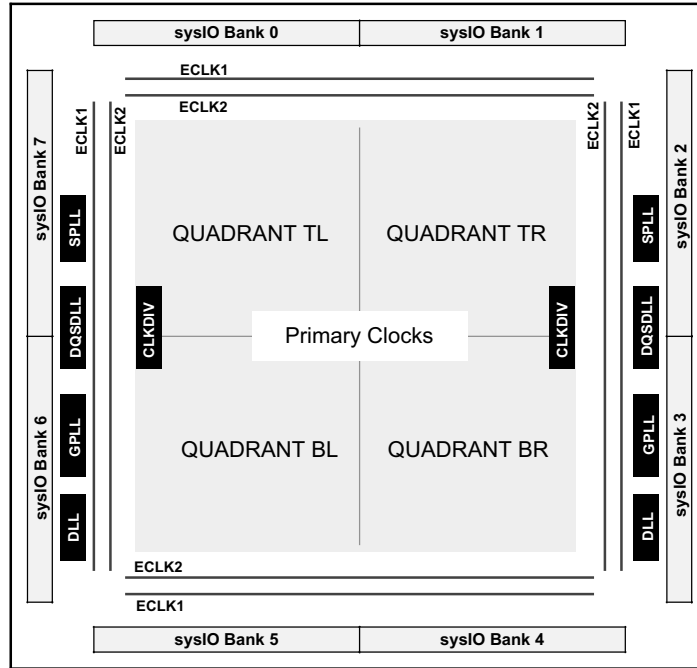
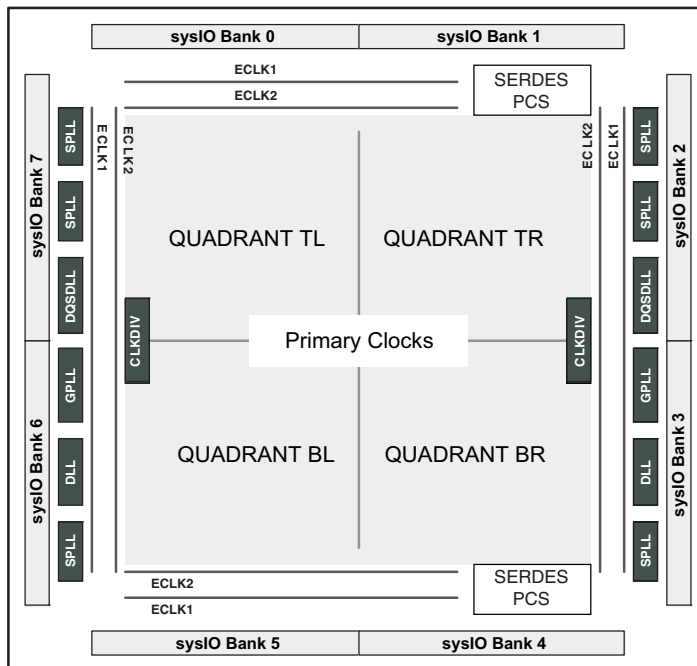


Figure 8-2 illustrates the primary clocking structure of the LatticeECP2M-50 device. The figure shows two SERDES blocks. The edge clocks on the top and bottom sides stop when they reach the SERDES block boundary. Other members of the LatticeECP2M family have a similar structure, except for the number of SERDES blocks.

Figure 10-2. LatticeECP2M-50 Clocking Structure



Primary Clocks

Each quadrant receives up to eight primary clocks. Two of these clocks provide the dynamic clock selection (DCS) feature. The six primary clocks without DCS can be specified in the Spreadsheet View in the ispLEVER Design Planner (or **Tools > Spreadsheet View** in the Lattice Diamond™ design software) as 'Primary Pure' and the two DCS clocks as 'Primary-DCS'.

The sources of the primary clocks are:

- PLL outputs
- DLL outputs
- CLKDIV outputs
- Dedicated clock pins
- Internal nodes
- SERDES TX_H_CLK (LatticeECP2M only)

Secondary Clocks

The LatticeECP2/M secondary clocks are a flexible region-based clocking resource. Each region can have four independent clock inputs. As a regional resource, it can cross the primary clock quadrant boundaries.

There are eight secondary clock muxes per region. Each mux has inputs from four different sources. Three of these are from internal nodes. The fourth input comes from a primary clock pin. The input sources are not necessarily located in the same region as the Mux. This structure enables global usage of secondary clocks.

The sources of secondary clocks are:

- Dedicated clock pins on right and left sides of device (PCLKT2, PCLKT3, PCLKT6, PCLKT7)
- Internal nodes

Edge Clocks

The LatticeECP2/M has two edge clocks per side. These clocks, which have low injection times and skew, are used to clock I/O registers. The edge clock (ECLK) resources are designed for high speed I/O interfaces with high fanout capability. Refer to Appendix B for detailed connectivity information.

The sources of the edge clocks are:

- Left and Right Edge Clocks
 - Dedicated clock pins
 - PLL outputs
 - DLL outputs
 - Internal nodes
- Top and Bottom Edge Clocks
 - Dedicated clock pins
 - Internal nodes

ECLK can directly drive the secondary clock resources and general routing resources. This means that an ECLK source clock can also route to the Primary Clock Net through general routing at the same time.

Figure 10-3 describes the secondary clock and edge clock structure.

Figure 10-3. LatticeECP2-50 Secondary Clocks and Edge Clocks

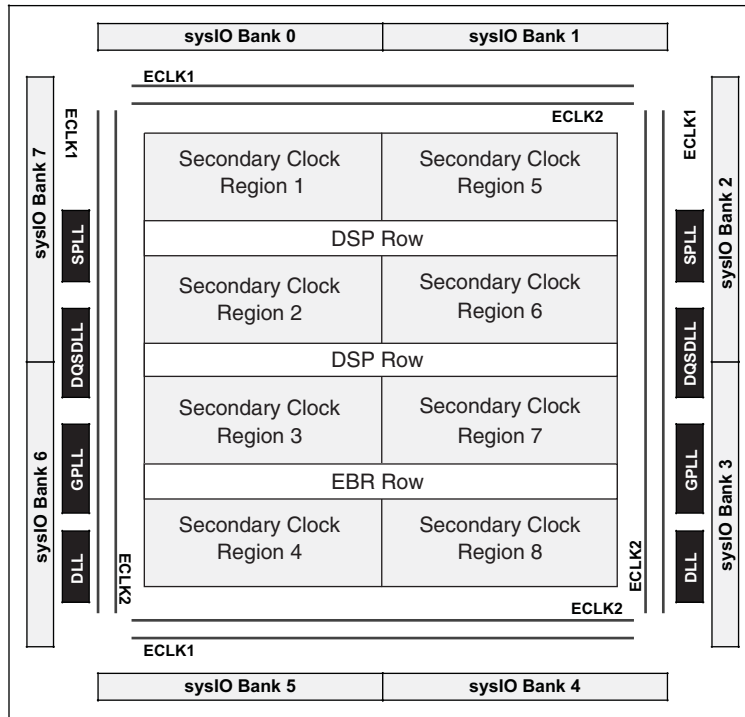
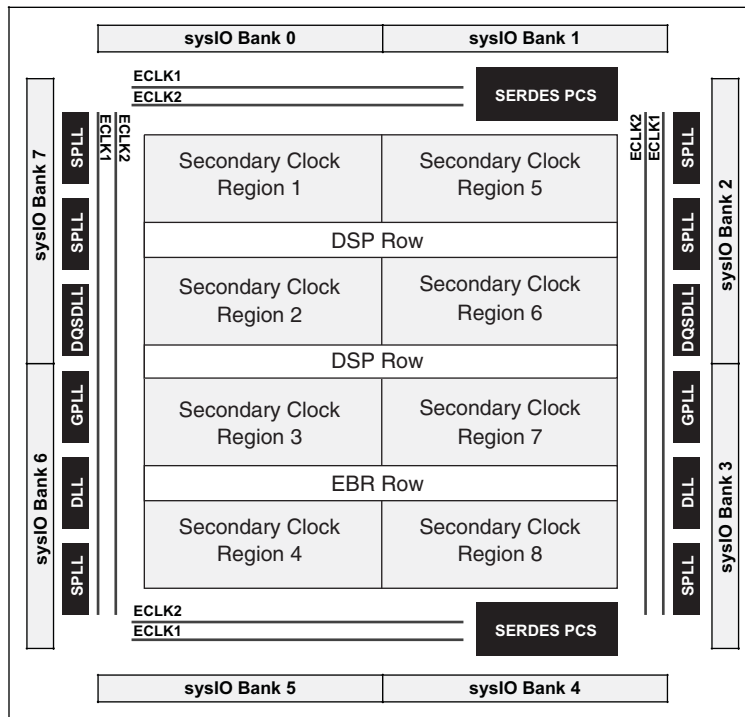


Figure 10-4. LatticeECP2M-50 Secondary Clocks and Edge Clocks



Note on Primary Clocks

The CLKOP must be used as the feedback source to optimize the PLL performance.

Most designers use PLL for clock tree injection removal mode and the CLKOP should be assigned to the Primary Clock. This is done automatically by the software unless the user specifies otherwise.

CLKOP can route to CLK0 to CLK5 only and CLKOS/CLKOK can route to all Primary Clocks (CLK0 to CLK7).

When CLK6 or CLK7 is used as a Primary Clock and there is only one clock input to the DCS, the DCS is assigned as a buffer mode by the software. See the DCS section of this document for further information.

Specifying Clocks in the Design Tools

If desired, designers can specify the clock resources, primary, secondary or edge to be used to distribute a given clock source. Figure 10-4 illustrates how this can be done in the Spreadsheet View in the ispLEVER Design Planner (or **Tools > Spreadsheet View** in Diamond). Alternatively the Preference file can be used, as discussed in Appendix C.

Primary-Pure and Primary-DCS

Primary Clock Net can be assigned to either Primary-Pure (CLK0 to CLK5) or Primary-DCS (CLK6 and CLK7).

Global Primary Clock and Quadrant Primary Clock

Global Primary Clock

If a primary clock is not assigned as a quadrant clock, the software assumes it is a Global Clock.

There are six Global Primary/Pure Clocks and two Global Primary/DCS Clocks available.

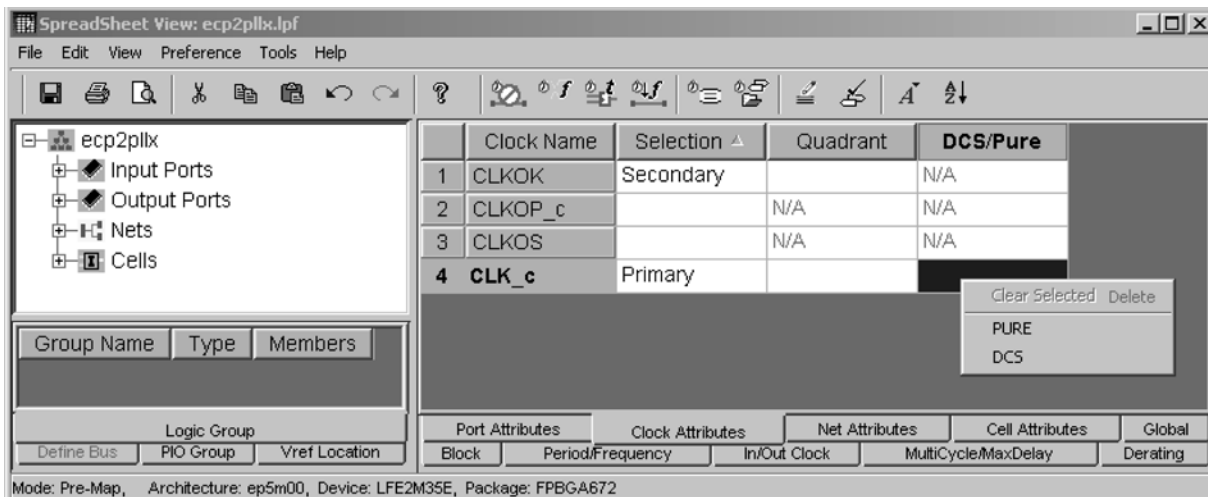
Quadrant Primary Clock

Any Primary Clock may be assigned to a Quadrant Clock. The clock may be assigned to a single quadrant or to two adjacent quadrants (not diagonally adjacent).

When a quadrant clock net is used, the user must ensure that the registers each clock drives can be assigned in that quadrant without any routing issues.

In the Quadrant Primary Clocking scheme, the maximum number of Primary Clocks is 32, as long as all the Primary Clock sources are available.

Figure 10-5. Design Planner Spreadsheet View (see Appendix D Figure 10-39 for Diamond Equivalent)



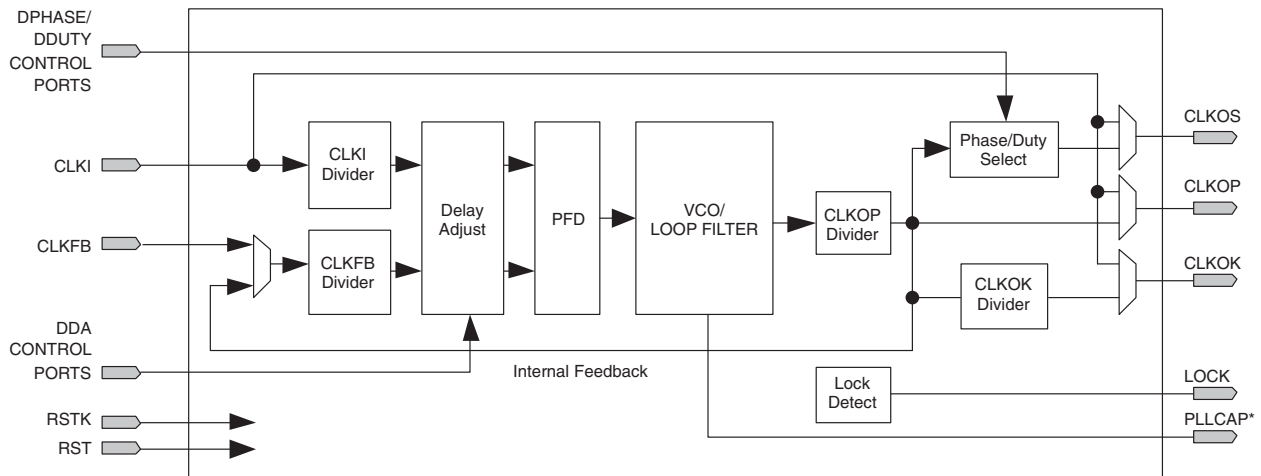
Note on Edge Clocks

Refer to Appendix A for detailed clock network diagrams.

sysCLOCK PLL

The LatticeECP2/M PLL provides features such as clock injection delay removal, frequency synthesis, phase/duty cycle adjustment, and dynamic delay adjustment. Figure 10-6 shows the block diagram of the PLL.

Figure 10-6. PLL Block Diagram



Functional Description

PLL Divider and Delay Blocks

Input Clock (CLKI) Divider

The CLKI divider is used to control the input clock frequency into the PLL block. The divider setting directly corresponds to the divisor of the output clock. The input and output of the input divider must be within the input and output frequency ranges specified in the device data sheet.

Feedback Loop (CLKFB) Divider

The CLKFB divider is used to divide the feedback signal. Effectively, this multiplies the output clock, because the divided feedback must speed up to match the input frequency into the PLL block. The PLL block increases the output frequency until the divided feedback frequency equals the input frequency. The input and output of the feedback divider must be within the input and output frequency ranges specified in the device data sheet.

Delay Adjustment

The delay adjust circuit provides programmable clock delay. The programmable clock delay allows for step delays in increments of 130ps (nominal) for a total of 1.04ns, lagging or leading. The time delay setting has a tolerance. See the device data sheet for details. Under this mode, CLKOP, CLKOS and CLKOK are identically affected. The delay adjustment has two modes of operation:

- **Static Delay Adjustment:** In this mode, the user-selected delay is configured at power-up.
- **Dynamic Delay Adjustment (DDA):** In this mode, a simple bus is used to configure the delay. The bus signals are available to the general purpose FPGA.

Output Clock (CLKOP) Divider

The CLKOP divider serves the dual purposes of squaring the duty cycle of the VCO output and scaling up the VCO frequency into the 640MHz to 1280MHz range to minimize jitter. The CLKOP Divider values are the same whether or not CLKOS is used.

CLKOK Divider

The CLKOK divider acts as a source for the global clock nets. It divides the CLKOP signal of the PLL by the value of the divider to produce a lower frequency clock.

Phase Adjustment and Duty Cycle Select

Users can program CLKOS with Phase and Duty Cycle options. Phase adjustment can be done in 22.5° steps. The Duty Cycle resolution is 1/16th of a period. However, 1/16th and 15/16th duty cycle options are not supported to avoid minimum pulse violation.

Dynamic Phase Adjustment (DPHASE) and Dynamic Duty Cycle (DDUTY) Select

With LatticeECP2/M device families, users can control the Phase Adjustment and Duty Cycle Select in dynamic mode. When this mode is selected, both the Phase Adjustment and Duty Cycle Select must be in Dynamic mode. If only one of the features is to be used in Dynamic mode, the other control inputs can be set with the fixed logic levels desired.

External Capacitor

An optional external capacitor can be used with PLLs to accommodate low frequency input clocks. See the Optional External Capacitor section of this document for further information.

PLL Inputs and Outputs

CLKI Input

The CLKI signal is the reference clock for the PLL. It must conform to the specifications in the [LatticeECP2/M Family Data Sheet](#) for the PLL to operate correctly. The CLKI can be derived from a dedicated dual-purpose pin or from routing.

RST Input

The PLL reset occurs under two conditions. At power-up an internal power-up reset signal from the configuration block resets the PLL. The user-controlled PLL reset signal RST is provided as part of the PLL module that can be driven by an internally generated reset function or a pin. This RST signal resets all internal PLL counters, flip-flops (including M-Dividers), and the charge pump. The M-Divider reset synchronizes the M-Divider output to the input clock. When RST goes inactive, the PLL will start the lock-in process, and will take the t_{LOCK} time to complete the PLL lock. Figure 10-7 shows the timing diagram of the RST Input. RST is active high.

The RESET signal is optional.

Figure 10-7. RST Input Timing Diagram

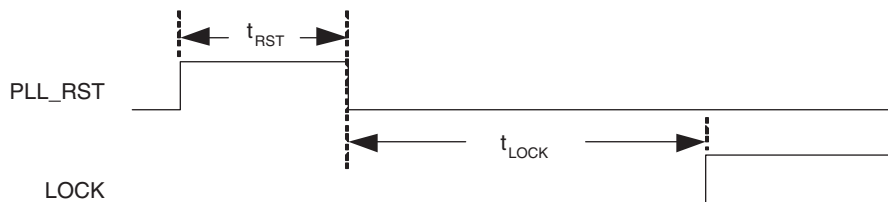
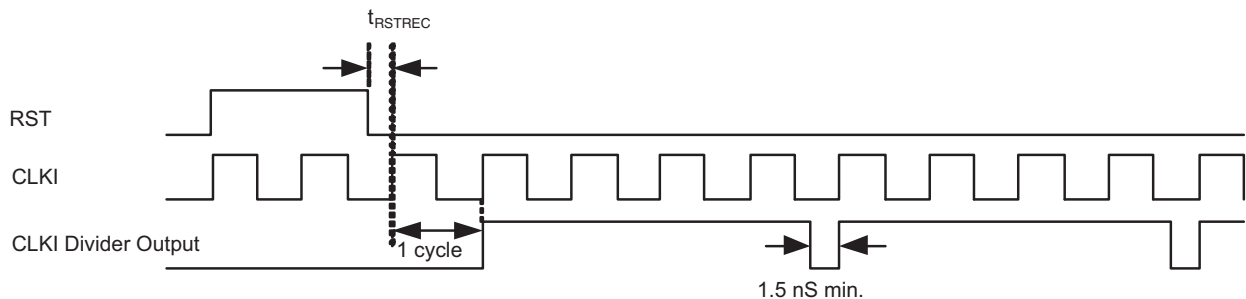


Figure 10-8 shows the timing relationship between RST and the CLKI Divider Output.

Figure 10-8. RST Input and CLKI Divider Output Timing Diagram (Example: CLKI_DIV = 4)

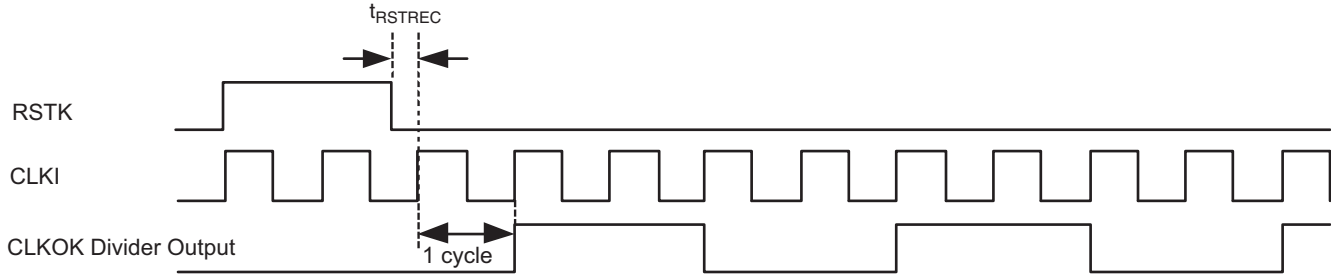


RSTK Input

RSTK is the reset input for the K-Divider. The K-Divider reset is used to synchronize the K-Divider output clock to the input clock. The LatticeECP2/M has an optional gearbox in the I/O cell for both outputs and inputs. The K-Divider reset is useful for the gearbox implementation. RSTK is active high.

Figure 10-9 shows the timing relationship between RSTK and CLKOK (example: CLKOK_DIV = 4)

Figure 10-9. RSTK Input and CLKOK Divider Output Timing Diagram (Example: CLKOK_DIV = 4)



CLKFB Input

The feedback signal to the PLL, which is fed through the feedback divider, can be derived from the Primary Clock net (CLKOP), a preferred pin, directly from the CLKOP divider (internal feedback) or from general routing. External feedback allows the designer to compensate for board-level clock alignment.

CLKOP Output

The sysCLOCK PLL main clock output, CLKOP, is a signal available for selection as a primary clock and an edge clock. This clock signal is available at the CLK_OUT pin.

CLKOS Output with Phase and Duty Cycle Select

The sysCLOCK PLL auxiliary clock output, CLKOS, is a signal available for selection as a primary clock and an edge clock. The CLKOS is used when phase shift and/or duty cycle adjustment is desired. The programmable phase shift allows for different phases in increments of 22.5°. The duty select feature provides duty selection in 1/16th of the clock period. This feature is also supported in Dynamic Control Mode.

CLKOK Output with Lower Frequency

The CLKOK is used when a lower frequency is desired. This signal is available for selection as a primary clock.

Dynamic Delay Control/Dynamic Phase Adjustment/Dynamic Duty Cycle

Detailed information about these features are described later in this document. The I/O ports for these features are illustrated in Table 10-3.

Table 10-3. Dynamic Delay Adjust and Dynamic Phase and Duty Cycle Adjust Ports

| Parameter | I/O | Description |
|--------------|-----|---|
| DDAMODE | I | DDA (Dynamic Delay Adjust) Mode. "1": Pin control (dynamic), "0": Fuse Control (static) |
| DDAIZR | I | DDA Delay Zero. "1": delay = 0, "0": delay = on |
| DDAILAG | I | DDA Lag/Lead. "1": Lead, "0": Lag |
| DDAIDEL[2:0] | I | DDA Delay Step value |
| DPAMODE | I | DPA (Dynamic Phase Adjust/Duty Cycle Select) mode. "1": Pin Pin control (dynamic), "0": Fuse Control (static) |
| DPHASE[3:0] | I | DPA Phase Adjust inputs |
| DDUTY[3:0] | I | DPA Duty Cycle Select inputs |

LOCK Output

The LOCK output provides information about the status of the PLL. After the device is powered up and the input clock is valid, the PLL will achieve lock within the specified lock time. Once lock is achieved, the PLL lock signal will

be asserted. If, during operation, the input clock or feedback signals to the PLL become invalid, the PLL will lose lock. However, when the input clock completely stops, the LOCK output will remain in its last state, since it is internally registered by this clock. It is recommended to assert PLL RST to re-synchronize the PLL to the reference clock. The LOCK signal is available to the FPGA routing to implement generation of RST. Simulation models take several reference clock cycles from RST release to LOCK high.

PLLCAP

This port is not included in the software module. Instead, it is hard-wired to the PLLCAP pin of the device. See the Optional External Capacitor section of this document for further information.

PLL Attributes

The PLL utilizes several attributes that allow the configuration of the PLL through source constraints and preference files. The following section details these attributes and their usage.

FIN

The input frequency can be any value within the specified frequency range based on the divider settings.

CLKI_DIV, CLKFB_DIV, CLKOP_DIV, CLKOK_DIV

These dividers determine the output frequencies of each output clock. The user is not allowed to input an invalid combination. This is determined by the input frequency, the dividers and the PLL specifications.

Note: Unlike PLLs in the LatticeECP™, LatticeEC™, LatticeXP™ and MacoXO™ devices, the CLKOP Divider values are the same whether or not CLKOS is used. The CLKOP_DIV value is calculated to maximize the f_{VCO} within the specified range based on FIN and CLKOP_FREQ in conjunction with CLKI_DIV and CLKFB_DIV values. These value settings are designed so that the output clock duty cycle is as close to 50% as possible.

FREQUENCY_PIN_CLKI, FREQUENCY_PIN_CLKOP, FREQUENCY_PIN_CLKOK

These input and output clock frequencies determine the divider values.

CLKOP Frequency Tolerance

When the desired output frequency is not achievable, the frequency tolerance of the clock output may be entered.

PHASEADJ (Phase Shift Adjust)

The PHASEADJ attribute is used to select Phase Shift for the CLKOS output. The phase adjustment is programmable in 22.5° increments.

DUTY (Duty Cycle)

The DUTY attribute is used to select the Duty Cycle for CLKOS output. The Duty Cycle is programmable at 1/16th of the period increment. Steps 2 to 14 are supported. 1/16th and 15/16th duty cycles are not supported to avoid the minimum pulse width violation.

FB_MODE

There are three sources of feedback signals that can drive the CLKFB Divider: Internal, CLKOP (Clock Tree) and User Clock. CLKOP (Clock Tree) feedback is used by default. Internal feedback takes the CLKOP output at the CLKOP Divider output (CLKINTFB) before the Clock Tree to minimize the feedback path delay. User Clock feedback is driven from the dedicated pin, clock pin or user specified internal logic.

DELAY_CNTL

This attribute is designed to select the Delay Adjustment mode. If the attribute is set to "DYNAMIC" the delay control switches between dynamic and static, depending upon the input logic of the DDAMODE pin. If the attribute is set to "STATIC", Dynamic Delay inputs are ignored in this mode.

PHASE/DUTY_CNTL

This attribute is designed to select the Phase Adjustment/Duty Cycle Select mode. If the attribute is set to “DYNAMIC” the Phase Adjustment/Duty Cycle Select control switches between dynamic and static, depending upon the input logic of the DPAMODE pin. If the attribute is set to “STATIC”, Dynamic Phase Adjustment/Duty Cycle Select inputs are ignored in this mode.

CLKOS/CLKOK Select

Users select these output clocks only when they are used in the design.

CLKOP/CLKOS/CLKOK BYPASS

These bypasses are enabled if set. The CLKI is routed directly to the corresponding output clock.

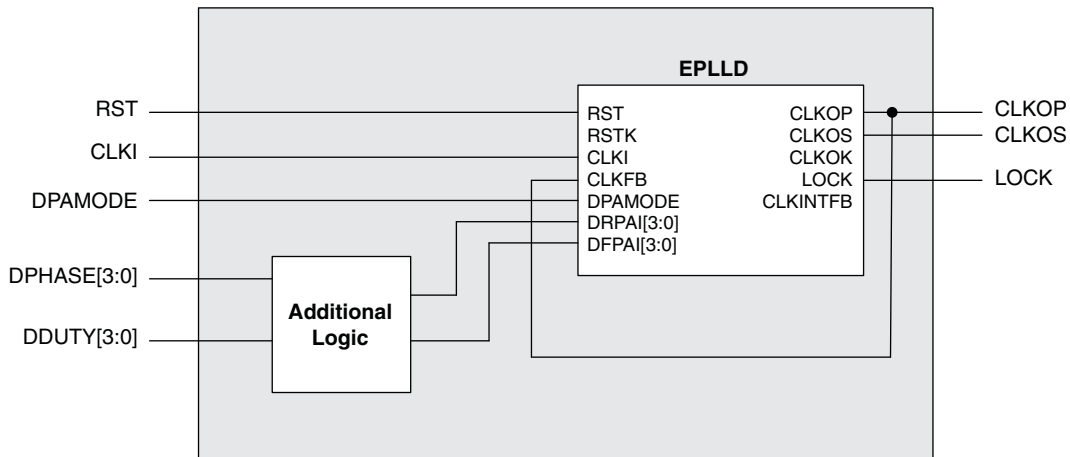
RESET/RSTK Select

Users select these reset signals only when they are used in the design.

LatticeECP2/M PLL Modules

When the user creates a PLL module using IPexpress, the module will consist of a wrapper around the PLL library element and any additional logic required for the module. Figure 10-10 shows a diagram of a typical PLL module. The module port names can be different than the library element in some cases. The user will see the module port names in the IPexpress window and also in the source code file for the generated module. These are the ports that will be connected in the user's design. IPexpress also creates an instantiation template file that shows the user how to instantiate the PLL module in their design. The user can import the *.LPC (or *.IPX for Diamond) file into their project or the generated source code file.

Figure 10-10. LatticeECP2/M Typical PLL Module Generated by IPexpress



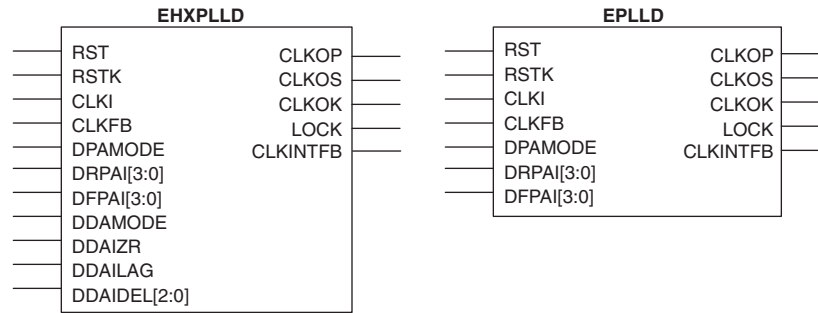
The PLL module shown in Figure 10-10 represents an example where the user has chosen to use the CLKOP and CLKOS ports, with a PLL reset signal, PLL lock signal, and dynamic phase and dynamic duty cycle. It also uses CLKOP feedback so the software will connect the CLKOP signal to the CLKFB port and use the primary clock tree to route this signal. The user would connect their signals to the CLKI, RST, DPAMODE, DPHASE[3:0], DDUTY[3:0], CLKOP, CLKOS, and LOCK signals.

LatticeECP2/M PLL Library Definitions

All LatticeECP2/M devices support two General Purpose PLLs (GPLLs) which are full-featured PLLs. In addition, some of the larger devices have two to six Standard PLLs (SPLLs) that have a subset of the GPLL functionalities.

Two PLL library elements are defined for LatticeECP2/M PLL implementation. Figure 10-11 shows the LatticeECP2/M PLL library symbols. The GPLL may be configured as either EPLLD or EHXPLLD. The SPLL can be configured as EPLLD only.

Figure 10-11. LatticeECP2/M PLL Library Symbols



Dynamic Delay Adjustment (EHXPLL Only)

The Dynamic Delay Adjustment is controlled by the DDAMODE input. When the DDAMODE input is set to “1”, the delay control is done through the inputs, DDAIZR, DDAILAG and DDAIDEL(2:0). For this mode, the attribute “DELAY_CNTL” must be set to “DYNAMIC”. Table 10-4 shows the delay adjustment values based on the attribute/input settings.

In this mode, the PLL may come out of lock due to the abrupt change of phase. RST must be asserted to re-lock the PLL. Upon de-assertion of RST, the PLL will start the lock-in process and will take the t_{LOCK} time to complete the PLL lock.

Table 10-4. Delay Adjustment

| DDAMODE = 1: Dynamic Delay Adjustment | | | Delay 1 Tdly = 130 ps (nominal) | DDAMODE = 0 |
|---------------------------------------|------------|--------------|---------------------------------|-----------------------|
| DDAIZR | DDAILAG | DDAIDEL[2:0] | | Equivalent FDEL Value |
| 0 | 1 | 111 | Lead 8 Tdly | -8 |
| 0 | 1 | 110 | Lead 7 Tdly | -7 |
| 0 | 1 | 101 | Lead 6 Tdly | -6 |
| 0 | 1 | 100 | Lead 5 Tdly | -5 |
| 0 | 1 | 011 | Lead 4 Tdly | -4 |
| 0 | 1 | 010 | Lead 3 Tdly | -3 |
| 0 | 1 | 001 | Lead 2 Tdly | -2 |
| 0 | 1 | 000 | Lead 1 Tdly | -1 |
| 1 | Don't Care | Don't Care | no delay | 0 |
| 0 | 0 | 000 | Lag 1 Tdly | 1 |
| 0 | 0 | 001 | Lag 2 Tdly | 2 |
| 0 | 0 | 010 | Lag 3 Tdly | 3 |
| 0 | 0 | 011 | Lag 4 Tdly | 4 |
| 0 | 0 | 100 | Lag 5 Tdly | 5 |
| 0 | 0 | 101 | Lag 6 Tdly | 6 |
| 0 | 0 | 110 | Lag 7 Tdly | 7 |
| 0 | 0 | 111 | Lag 8 Tdly | 8 |

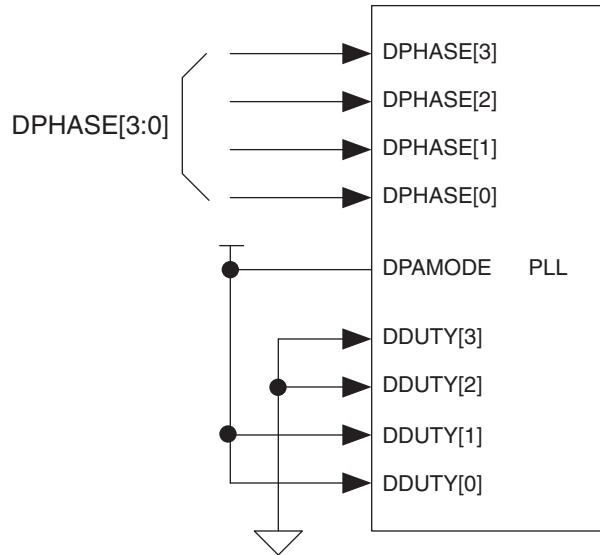
Dynamic Phase/Duty Mode

This mode sets both Dynamic Phase Adjustment and Dynamic Duty Select at the same time.

There are two modes, “Dynamic Phase and Dynamic Duty” and “Dynamic Phase and 50% Duty”.

To use Dynamic Phase Adjustment with a fixed Duty Cycle, simply set the DDUTY[3:0] inputs to the desired Duty Cycle value. Figure 10-12 illustrates an example circuit. This example assumes the user-desired Duty Cycle is 3/16.

Figure 10-12. Example Dynamic Phase Adjustment Set-up with Duty Cycle Fixed to 3/16



Dynamic Phase Adjustment/Duty Cycle Select

Phase Adjustment settings are described in Table 10-5.

Table 10-5. Dynamic Phase Adjustment Settings

| DPHASE[3:0] | Equivalent to PHASEADJ in Static Mode |
|-------------|---------------------------------------|
| 0000 | 0 |
| 0001 | 22.5 |
| 0010 | 45 |
| 0011 | 67.5 |
| 0100 | 90 |
| 0101 | 112.5 |
| 0110 | 135 |
| 0111 | 157.5 |
| 1000 | 180 |
| 1001 | 202.5 |
| 1010 | 225 |
| 1011 | 247.5 |
| 1100 | 270 |
| 1101 | 292.5 |
| 1110 | 315 |
| 1111 | 337.5 |

Duty Cycle Select settings are described in Table 10-6.

Table 10-6. Dynamic Duty Cycle Select Settings

| DDUTY[3:0] | Equivalent to DUTY in Static Mode (1/16 of Period) | Comment |
|------------|--|---------------|
| 0000 | 0 | Not Supported |
| 0001 | 1 | Not Supported |
| 0010 | 2 | |
| 0011 | 3 | |
| 0100 | 4 | |
| 0101 | 5 | |
| 0110 | 6 | |
| 0111 | 7 | |
| 1000 | 8 | |
| 1001 | 9 | |
| 1010 | 10 | |
| 1011 | 11 | |
| 1100 | 12 | |
| 1101 | 13 | |
| 1110 | 14 | |
| 1111 | 15 | Not Supported |

Optional External Capacitor

An optional external capacitor can be used with both the EHXPLLD and the EPLLD to change the frequency response of the on-chip loop filter. When an external capacitor is used, the frequency at the phase detector inputs (Fpd) can be as low as 2MHz, allowing the PLLs to extend the low-end of their operating ranges. Using the external capacitor will limit the high end of the PLL operating range as shown in the [LatticeECP2/M Family Data Sheet](#). IPexpress™ checks the phase detector frequency to determine if an external capacitor is required.

The allowable ranges for the PLL parameters with and without the external capacitor are described in the [LatticeECP2/M Family Data Sheet](#).

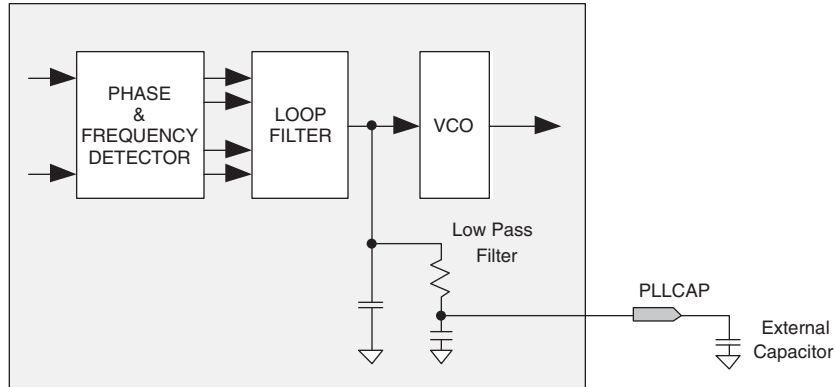
Recommended Optional External Capacitor Specifications

Value: 5.6 nF, +/- 20%
 Type: Ceramic chip capacitor, NPO dielectric
 Package: 1206 or smaller

Each device has two external capacitor pins, one for the left side PLLs and one for the right side PLLs. These pins are in fixed locations. They are dedicated function pins that are NOT shared with user I/Os.

When an external capacitor pin is used by a PLL on one side of the device, it cannot be used by any other PLLs on the same side of the device. This means that a maximum of two PLLs per device, one on the left side and one on the right side, can have external capacitors attached.

Figure 10-13. External Capacitor Usage

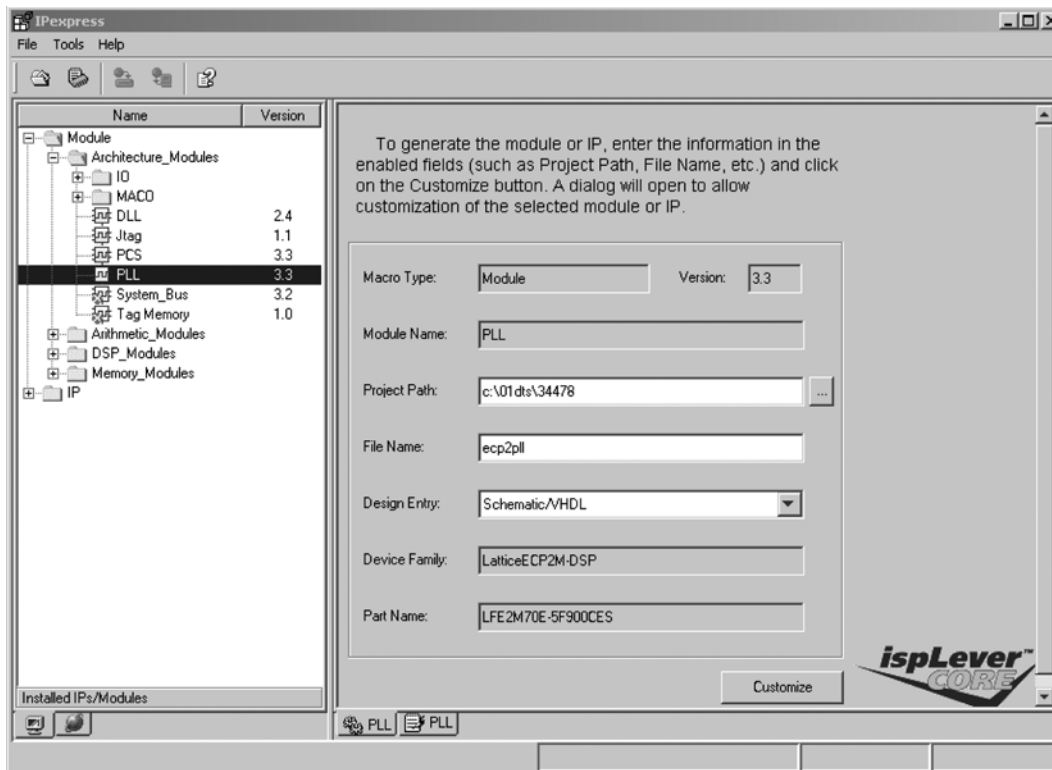


PLL Usage in IPexpress

IPexpress is used to create and configure a PLL. Designers use the graphical user interface to select parameters for the PLL. The result is an HDL model to be used in the simulation and synthesis flow.

Figure 10-14 shows the main window when PLL is selected. The only entry required in this window is the module name. Other entries are set to the project settings. These entries may be changed if desired. After entering the module name, click on **Customize** to open the **Configuration Tab** window as shown in Figure 10-15.

Figure 10-14. IPexpress Main Window (see Appendix D Figure 10-40 for Diamond Equivalent)



Configuration Tab

The Configuration Tab lists all user-accessible attributes with default values set. Upon completion, click **Generate** to generate source and constraint files. The user may choose to use the *.LPC file (or *.IPX file for Diamond projects) to load parameters.

Modes

There are two modes for configuring the PLL in the Configuration Tab: Frequency Mode and Divider Mode.

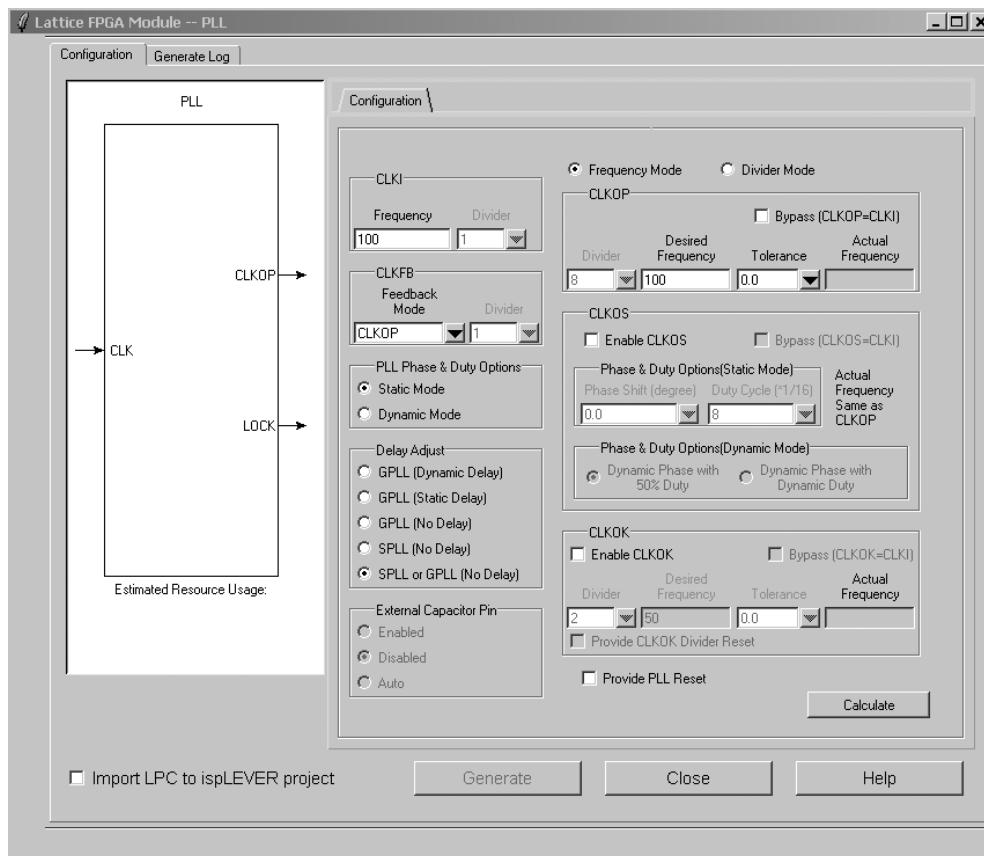
Frequency Mode

In this mode, the user enters input and output clock frequencies and the software calculates the divider settings. If the output frequency entered is not achievable, the nearest frequency will be displayed in the 'Actual' text box. After input and output frequencies are entered, clicking the **Calculate** button will display the divider values.

Divider Mode

In this mode, the user sets the divider settings with the input frequency. The user must choose the CLKOP Divider value in order to maximize the f_{VCO} and achieve optimum PLL performance. After setting the input frequency and divider settings, click **Calculate** to display the frequencies. Figure 10-15 shows the Configuration Tab.

Figure 10-15. LatticeECP2/M PLL Configuration Tab



Note: In the External Capacitor Pin, the grayed out text will automatically indicate the requirement for the external loop capacitor based upon the PLL settings. This is used to alert the user that the external loop capacitor may be required. The Auto setting indicates that the software will determine if the external loop capacitor is required after the PLL is placed into an SPLL or GPLL by the Place and Route (PAR) step. Other grayed-out sections of this dialog box turn on as their sections are enabled.

Table 10-7 describes all user parameters in the IPexpress GUI.

Table 10-7. User Parameters in the Configuration GUI

| User Parameters | | Description | Range | Default |
|--------------------------------|--|--|---|---------|
| Frequency Mode | | Desired input/output frequency | ON/OFF | ON |
| Divider Mode | | Desired input frequency and divider settings | ON/OFF | OFF |
| CLKI | Frequency | Without external capacitor | 25 (33 ¹) MHz to 420 MHz | 100 MHz |
| | | With external capacitor | 2 MHz to 420 MHz ² | — |
| | Divider | Without external capacitor | 1 to 16(12 ¹) | 1 |
| | | With external capacitor | 1 to 64 | — |
| CLKFB | Feedback Mode | Feedback Mode | Internal, CLKOP, User clock | CLKOP |
| | Divider | Without external capacitor | 1 to 16 (12 ¹) | 1 |
| | | With external capacitor | 1 to 10 | - |
| CLKOP | Bypass | Bypass PLL: CLKOP = CLKI | ON/OFF | OFF |
| | Desired Frequency | Without external capacitor | 25(331) MHz to 420 MHz | 100 MHz |
| | | With external capacitor | 5 MHz to 50 MHz ³ | — |
| | Divider | CLKOP Divider Setting (Divider Mode) | 2,4,8,16,32,48, 64,80,96,112,128 | 8 |
| | Tolerance | CLKOP tolerance users can tolerate | 0.0, 0.1, 0.2, 0.5, 1.0, 2.0, 5.0, 10.0 | 0.0 |
| Actual Frequency | Actual frequency achievable, Read only | — | — | |
| CLKOS | Enable | Enable CLKOS output clock | ON/OFF | OFF |
| | Bypass | Bypass PLL: CLKOS = CLKI | ON/OFF | OFF |
| | Phase - Static | CLKOS Static Phase Shift | 0°, 22.5°, 45°, , 337.5° | — |
| | Duty - Static | CLKOS Static Duty Cycle Select | 2 to 14 | 8 |
| | Dynamic Phase with 50% Duty | Dynamic Phase and 50% Duty Cycle | ON/OFF | ON |
| | Dynamic Phase with Dynamic Duty | Dynamic Phase and Dynamic Duty Cycle | ON/OFF | ON |
| CLKOK | Enable | Enable CLKOK output clock | ON/OFF | OFF |
| | Bypass | Bypass PLL: CLKOK = CLKI | ON/OFF | OFF |
| | Desired Frequency | Without external capacitor | 0.195 MHz to 210 MHz | 50 MHz |
| | | With external capacitor | 0.016 MHz to 25 MHz ³ | — |
| | Divider | CLKOK Divider Setting (Divider Mode) | 2 to 128 (all even numbers) | 2 |
| | Tolerance | CLKOK tolerance users can tolerate | 0.0, 0.1, 0.2, 0.5, 1.0, 2.0, 5.0, 10.0 | 0.0 |
| | Actual Frequency | Actual frequency achievable, Read only | — | — |
| PLL Phase & Duty Option | Dynamic/Static Mode selection | Dynamic Mode/Static Mode | Static Mode | |
| Delay Adjust | Dynamic/Static/No delay selection | Dynamic/Static/No Delay | No Delay ⁴ | |
| Provide PLL Reset | Provide PLL Reset Port | ON/OFF | OFF | |
| Provide CLKOK Divider Reset | Provide CLKOK Reset Port | ON/OFF | OFF | |
| Import LPC to ispLEVER project | Import .lpc file to ispLEVER project | ON/OFF | OFF | |

1. These values apply to SPLL. All other values apply to both GPLL and SPLL.

2. Phase Detector Input Frequency range 2 MHz to 50MHz.

3. For $f_{IN} < 5\text{MHz}$, $f_{OUT_max} = 10 * f_{IN}$.

4. IPExpress gives the user the ability to select the GPLL, SPLL, or to let the software choose, based upon the settings in the Delay Adjust section.

Frequency Calculation

Table 10-8 illustrates the Frequency limits at the Phase Detector inputs. Users must select CLKI Divider and CLKFB Divider values so that the Phase Detector Frequency falls within the range.

Let M = CLKI divider value
N = CLKFB divider value
V = CLKOP divider value

The basic equations are:

$$\text{CLKOP Frequency} = \text{CLKI Frequency} * N/M$$

$$f_{\text{VCO}} \text{ (VCO Frequency)} = \text{CLKOP Frequency} * V$$

$$f_{\text{PFD}} \text{ (PFD Frequency)} = \text{CLKI Frequency} / M = \text{CLKFB Frequency} (= \text{CLKOP Frequency}) / N$$

Example: If CLKI frequency is 25 MHz without external capacitor, the CLKI divider value can be only 1.

Table 10-8. Phase Detector Frequency (f_{PFD}) Range

| PLL Type | External Capacitor | Frequency Range |
|----------|----------------------------|------------------------------|
| GPLL | Without external capacitor | 25 MHz to 420 MHz |
| | With external capacitor | 2 MHz to 50 MHz ¹ |
| SPLL | Without external capacitor | 33 MHz to 420 MHz |
| | With external capacitor | 2 MHz to 50 MHz ¹ |

1. For $f_{\text{IN}} < 5\text{MHz}$, $f_{\text{OUT_max}} = 10 * f_{\text{IN}}$.

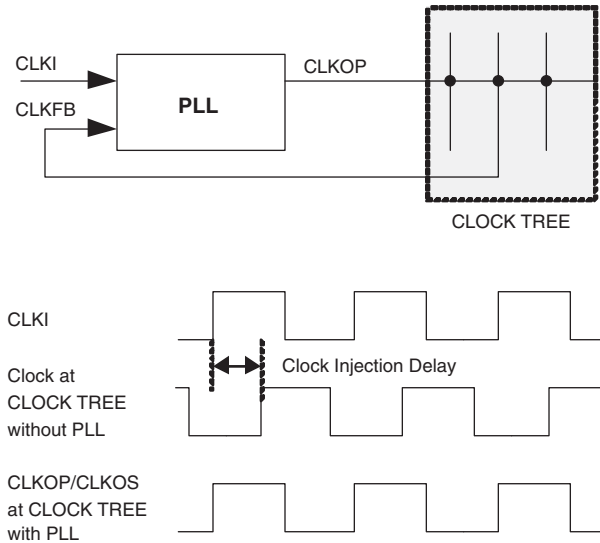
PLL Modes of Operation

PLLs have many uses within logic design. The two most popular are clock injection removal and clock phase adjustment. These two modes of operation are described below.

PLL Clock Injection Removal

In this mode, the PLLs are used to reduce clock injection delay. Clock injection delay is the delay from the input pin of the device to a destination element such as a flip-flop. The phase detector of the PLL aligns the CLKI with CLKFB. If the CLKFB signal comes from the clock tree (CLKOP), then the PLL delay and the clock tree delay is removed. Figure 10-16 Illustrates an example block diagram and waveform.

Figure 10-16. Clock Injection Delay Removal Application

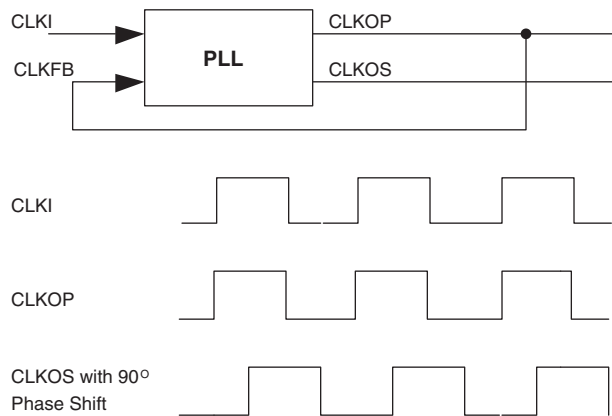


PLL Clock Phase Adjustment

In this mode, the PLLs are used to create fixed phase relationships in 22.5° increments. Creating fixed phase relationships are useful for forward clock interfaces where a specific relationship between the clock and data is required.

The fixed phase relationship can be used between CLKI and CLKOS or between CLKOP and CLKOS.

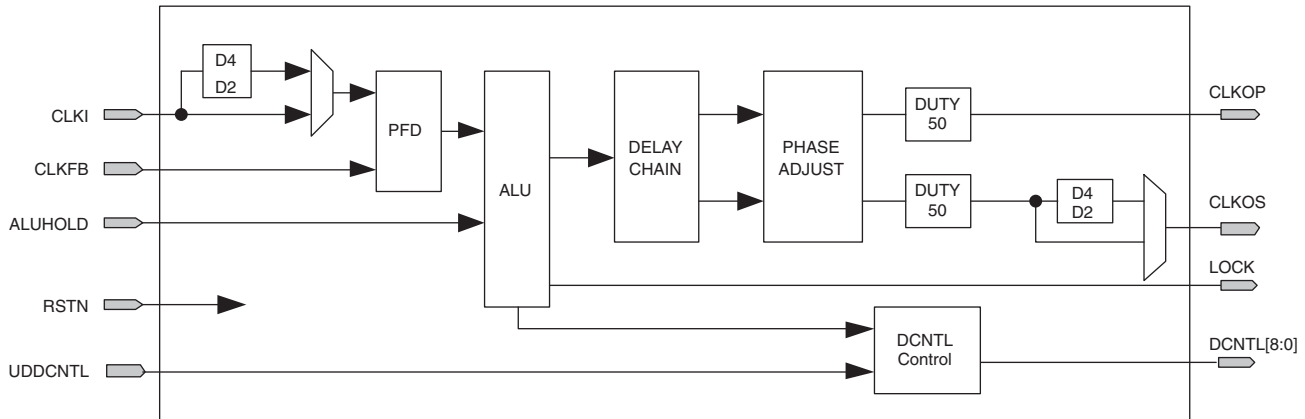
Figure 10-17. CLKOS Phase Adjustment from CLKOP



sysCLOCK DLL

The LatticeECP2/M DLL provides features such as clock injection delay removal, delay match, time reference delay (90° phase delay), and output phase adjustment. The DLL performs clock manipulation by adding delay to the CLKI input signal to create specific phase relationships. There are two types of outputs of the DLL. The first are clock signals similar to the PLL CLKOP and CLKOS. The other type of output is a delay control vector (DCNTL[8:0]). The delay control vector is connected to a Slave Delay Line (DLLDEL) element located in the I/O logic which matches the delay cells in the DLL. This delay vector allows the DLL to dynamically delay an input signal by a specific amount. Figure 10-18 provides a block diagram of the LatticeECP2/M DLL.

Figure 10-18. LatticeECP2/M DLL Block Diagram



Both clock injection delay removal and output phase adjustment use only the clock outputs of the DLL. Time reference delay and delay match modes use the delay control vector output. Specific examples of these features are discussed later in this document.

DLL Overview

The LatticeECP2/M DLL is created and configured by IPexpress. The following is a list of port names and descriptions for the DLL. There are two library elements used to implement the DLL: CIDDLLA (Clock Injection Delay), and TRDDLLA (Time Reference Delay). IPexpress will wrap one of these library elements to create a customized DLL module based on user selections.

DLL Inputs and Outputs

CLKI Input

The CLKI signal is the reference clock for the DLL. The CLKI input can be sourced from any type of FPGA routing and pin. The DLL CLKI input has a preferred pin per DLL which provides the lowest latency and best case performance.

CLKFB Input

The CLKFB input is available only if the user chooses to use a user clock signal for the feedback or in clock delay match mode. If internal feedback or CLKOS/CLKOP is used for the feedback, this connection will be made inside the module. In Clock Injection Delay Removal mode, the DLL will align the input clock phase with the feedback clock phase by delaying the input clock.

In Clock Injection Delay Match mode, the DLL will calculate the delta between the CLKI and CLKFB signals. This delay value is then output on the DCNTL vector. The DLL CLKFB input has a preferred pin per DLL which is discussed later in this document. The preferred pin provides the lowest latency and best case performance.

CLKOP Output

An output of the DLL based on the CLKI rate. The CLKOP output can drive primary and edge clock routing.

CLKOS Output

An output of the PLL based on the CLKI rate which can be divided and/or phase shifted. The CLKOS output can drive the primary and edge clock routing.

DCNTL[8:0] Output

This output of the DLL is used to delay a signal by a specific amount. The DCNTL[8:0] vector connects to a Slave Delay Line element. The DLL can then control multiple input delays from a single DLL.

UDDCNTL Input

This input is used to enable or disable updating of the DCNTL[8:0]. To ensure that the signal is captured by the synchronizer in the DLL block, it must be driven high for a time equal to at least two clock cycles when an update is required. If the signal is driven high and held in that state, the DCNTL[8:0] outputs are continuously updated.

ALUHOLD Input

This active high input stops the DLL from adding and subtracting delays to the CLKI signal. The DCNTL[8:0], CLKOP, and CLKOS outputs will still be valid, but will not change from the current delay setting.

LOCK Output

Active high lock indicator output. The LOCK output will be high when the CLKI and CLKFB signal are in phase. If the CLKI input stops the LOCK output will remain asserted. The clock is stopped so there is no clock to de-assert the LOCK output. Note that this is different from the operation of the PLL where the VCO continues to run when the input clock stops.

RSTN

Active low reset input to reset the DLL. The DLL can optionally be reset by the GSRN as well. It is recommended that if the DLL requires a reset, the reset should not be the same as the FPGA logic reset. Typically, logic requires that a clock is running during a reset condition. If the data path reset also resets the DLL, the source of the logic clock will stop and this may cause problems in the logic.

DLL Attributes

The LatticeECP2/M DLL utilizes several attributes that allow the configuration of the DLL through source constraints, IPexpress and preference files. The following section details these attributes and their usage.

DLL Lock on Divide by 2 or Divide by 4 CLKOS Output

Usually, the DLL is a 'times one' device, allowing neither frequency multiplication or division. But the LatticeECP2/M DLL allows 'divide by 2' or 'divide by 4' CLKOS outputs. Two optional 'divide by 2' and 'divide by 4' blocks are placed at the CLKI input as well as the CLKOS and this enables the use of divided CLKOS in the DLL feedback path. This allows the DLL to perform clock injection removal on a 'divide by 2' or 'divide by 4' clock, which is useful for DDRX2 and DDRX4 modes of I/O buffer operation.

When this optional clock divider is used only in the CLKOS output path, it allows the DLL to output two time-aligned clocks at different frequencies. When the divider is set to divide by 2 or divide by 4, a 'dummy' delay is inserted in the CLKOP output path to match the clock to Q delay of the CLKOS divider.

Optional Clock Fine Phase Shift

The optional fine phase shift in the CLKOS output path is built from a delay block that matches the other four blocks in the main delay chain. This delay block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position.

GSR

The DLL can be reset by the GSR, if enabled. The GSR keyword can be set to ENABLED/DISABLED. This option is provided in the IPexpress GUI. Below is an example of the use of this preference.

```
ASIC "dll/dll_0_0" TYPE "CIDDLA" GSR=DISABLED;
```

DLL Lock Time Control

The DLL will lock when the CLKI and CLKFB phases are aligned. In a simulation environment, the lock time is fixed to 100 μ s (default). This value can be changed through an HDL parameter or preference (for the back annotation simulation). The DLL contains a parameter named LOCK_DELAY which accepts an integer value for the total time in μ s until the lock output goes high. Below is an example of how to set this value for front-end simulation.

Lattice Semiconductor

Verilog:

```
defparam mydll.mypll_0_0.LOCK_DELAY=500;
mydll dll_inst(.CLKI(clkin), .CLKOP(clk1), .CLKOS(clk2),
```

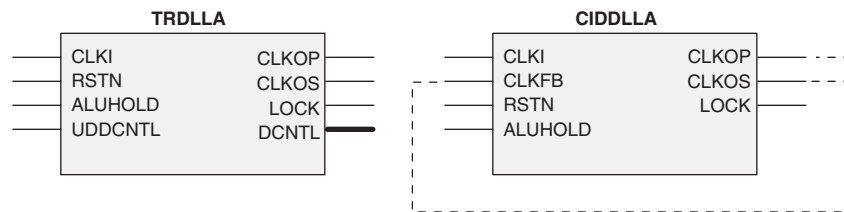
VHDL:

Not supported. For back annotation simulation LOCK_DELAY needs to be set in the preference file. Below is an example for the PLL.

```
ASIC "pll/p11_0_0" TYPE "EHXPLLA" LOCK_DELAY=200;
```

DLL Library Symbols

Figure 10-19. DLL Library Symbols



DLL Library Definitions

The Lattice library contains library elements to allow designers to utilize the DLL. These library elements use the DLL attributes defined in the “DLL Attributes” section.

The two modes of operation are presented as library elements as listed below.

Table 10-9. DLL Library Elements

| Library Element Name | Mode of Operation | Description |
|----------------------|--|---|
| TRDLLA | Time Reference Delay DLL | This mode generates four phases of the clock, 0°, 90°, 180°, 270°, along with the control setting used to generate these phases. |
| CIDDLLA | Clock Injection Delay DLL (Four Delay Cell Mode) | This mode removes the clock tree delay, aligning the external feedback clock to the reference clock. It has a single output coming from the fourth delay block. |

DLL Library Element I/Os

Table 10-10. DLL Library Element I/O Descriptions

| Signal | I/O | Description |
|------------|-----|--|
| CLKI | I | Clock input pin from dedicated clock input pin, other I/O or logic block. |
| CLKFB | I | Clock feedback input pin from dedicated feedback input pin, internal feedback, other I/O or logic block. This signal is not user selectable. |
| RSTN | I | Active low synchronous reset. From dedicated pin or internal node. |
| ALUHOLD | I | “1” freezes the ALU. For TRDLLA and CIDDLLA. |
| UDDCNTL | I | Active high synchronous enable signal from CIB for updating digital control to PIC delay. It must be driven high at least two clock cycles. |
| DCNTL[8:0] | O | Digital delay control code signals. |
| CLKOP | O | The primary clock output for all possible modes. |
| CLKOS | O | The secondary clock output with finer phase shift and/or division by 2 or by 4. |
| LOCK | O | Active high phase lock indicator. Lock means the reference and feedback clocks are in phase. |

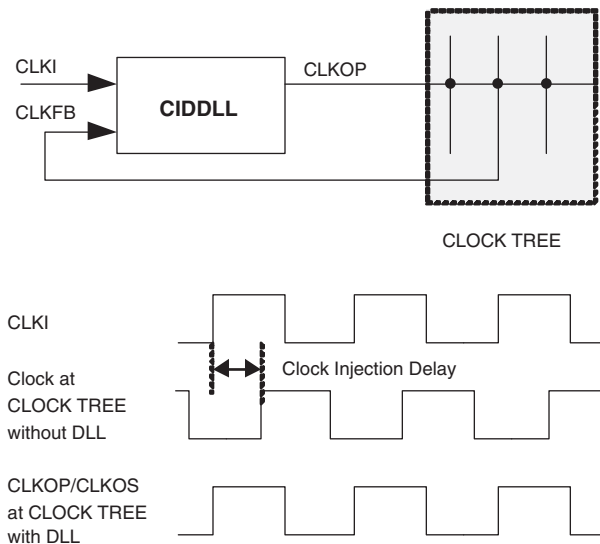
Note: Refer to device data sheet for frequency specifications.

DLL Modes of Operation

Clock Injection Removal Mode (CIDDLLA)

The DLL can be used to reduce clock injection delay (CIDDLLA). Clock injection delay is the delay from the input pin of the device to a destination element such as a flip-flop. The DLL will add delay to the CLKI input to align CLKI to CLKFB. If the CLKFB signal comes from the clock tree (CLKOP, CLKOS) then the delay of the DLL and the clock tree will be removed from the overall clock path. Figure 10-20 shows a circuit example and waveform.

Figure 10-20. Clock Injection Delay Removal via DLL



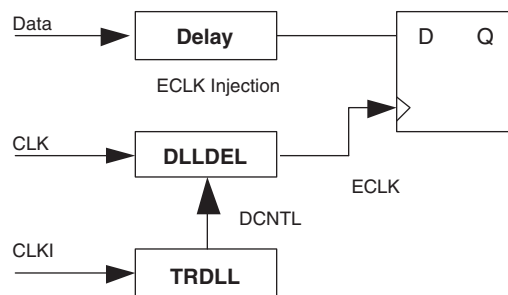
Clock injection removal mode can also provide a DCNTL port. In this mode, the delay added to the CLKI signal is output on the DCNTL port so that other input signals can be delayed by the same amount. This is very useful if several clocks are used in the same circuit to minimize the number of DLLs required. When using the DCNTL, the DLL delay will be limited to the range of the DCNTL vector. Therefore, IPexpress will restrict the CLKI rate from 300MHz to 700MHz.

Time Reference Delay Mode (TRDLLA: 90-Degree Phase Delay)

The Time Reference Delay (TRDDLLA) mode of the DLL is used to calculate 90 degrees of delay to be placed on the DCNTL vector. This is a useful mode in delaying a clock 90 degrees for use in clocking a DDR type interface.

Figure 10-21 provides a circuit example of this mode.

Figure 10-21. Time Reference Delay Circuit Example



In this mode, CLKI accepts a clock input. The DLL produces a DCNTL vector that will delay an input signal by 90 degrees of a full period of the CLKI signal. This DCNTL vector can then be connected to a Slave Delay Line (DLL-DELA) to delay the signal by 90 degrees of the full period of CLKI.

DLL Usage in IPexpress

IPexpress is used to create and configure a DLL. The IPexpress graphical user interface allows users to select parameters for the DLL. The result is an HDL model to be used in the simulation and synthesis flow.

Configuration Tab

- **Usage Mode** – Select the mode of the DLL (Time Reference Delay [TRDLLA] or Clock Injection Delay Removal [CIDDLLA]). This selection will enable or disable further options in the GUI.
- **CLKI Frequency** – The rate of the CLKI input in MHz.
- **CLKOS Divider** – Set the divider for the CLKOS output to be either no divide, divide by 2, or divide by 4.
- **CLKOS Phase Shift** – Set the phase offset of the CLKOS to the CLKOP output. CLKOP will lead CLKOS by the amount of phase shift selected. The phase increment is 11.25 degrees. The pull-down list numbers are abbreviated to a decimal point.
- **CLKFB Feedback Mode** – Sets the feedback mode of the DLL to either CLKOP, CLKOS or User Clock. If CLKOP/CLKOS is selected, the clock tree injection delay for the specific output clock will be removed. If User Clock is selected, the user will be provided with the CLKFB port on the DLL.
- **CLKFB Frequency** – This is used only with User Clock Feedback Mode.
- **Provide RSTN Port** – The RSTN port allows the user to reset the DLL through a user signal.

PLL/DLL Cascading

It is possible to connect several arrangements of PLLs and DLLs. There are three possible cascading schemes:

- PLL to PLL
- PLL to DLL
- DLL to DLL

It is not possible to connect the DLL to a PLL. The DLL produces abrupt changes on its output clocks when changing delay settings. The PLL sees this as radical phase changes that prevent the PLL from locking correctly.

IPexpress Output

There are two outputs of IPexpress that are important for use in the design. The first is the <module_name>.[v|vhd] file. This is the user-named module that was generated by the tool to be used in both synthesis and simulation flows. The second file is a template file <module_name>_tmpl.[v|vhd]. This file contains a sample instantiation of the module. This file is only provided for the user to copy/paste the instance and is not intended to be used in the synthesis or simulation flows directly.

For the PLL/DLL, IPexpress sets attributes in the HDL module created that are specific to the data rate selected. Although these attributes can easily be changed, they should only be modified by re-running the GUI so that the performance of the PLL/DLL is maintained. After the map stage in the design flow, FREQUENCY preferences will be included in the preference file to automatically constrain the clocks produced from the PLL/DLL.

Clock Dividers (CLKDIV)

The clock divider divides the high-speed clock by 2, 4 and 8. The divided output can then be used as a primary clock or secondary clock input. The clock dividers are used for providing the low-speed FPGA clocks for shift registers (x2, x4, x8) and DDR/SPI4 I/O logic interfaces. There are two clock dividers, one on each side.

CLKDIV Library Element Definition

Users can instantiate CLKDIV in the source code as defined in this section. Figure 10-22, Table 10-11 and Table 10-12 describe the definition of CLKDIVB.

Figure 10-22. CLKDIV Library Symbol

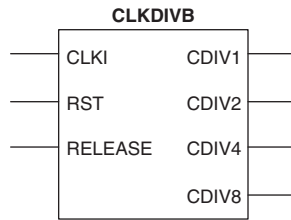


Table 10-11. CLKDIVB Port Definitions

| Name | Description |
|----------------------|---|
| CLKI | Clock input |
| RST ¹ | Reset input, asynchronously forces all outputs low. |
| RELEASE ¹ | Releases outputs synchronously to input clock. |
| CDIV1 | Divided by 1 output |
| CDIV2 | Divided by 2 output |
| CDIV4 | Divided by 4 output |
| CDIV8 | Divided by 8 output |

1. Note: Unused RST must be tied to ground. Unused RELEASE must be tied to V_{CC}.

Table 10-12. CLKDIVB Attribute Definition

| Name | Description | Value | Default |
|------|-------------|------------------|----------|
| GSR | GSR Enable | ENABLED/DISABLED | DISABLED |

CLKDIV Declaration in VHDL Source Code

```

COMPONENT CLKDIVB
-- synthesis translate_off
    GENERIC (
        GSR           : in String);
-- synthesis translate_on
    PORT (
        CLKI,RST, RELEASE:IN    std_logic;
        CDIV1, CDIV2, CDIV4, CDIV8:OUT    std_logic);
END COMPONENT;

attribute GSR : string;
attribute GSR of CLKDIVinst0 : label is "DISABLED";

begin

CLKDIVinst0:CLKDIVB
-- synthesis translate_off
    GENERIC MAP(
        GSR           => "disabled"
    );
-- synthesis translate_on
    PORT MAP(
        CLKI           => CLKIsig,
        RST            => RSTsig,
        RELEASE        => RELEASEsig,
    );

```

```
    CDIV1      => CDIV1sig,  
    CDIV2      => CDIV2sig,  
    CDIV4      => CDIV4sig,  
    CDIV8      => CDIV8sig  
  );  
  
end
```

CLKDIV Usage with Verilog - Example

```
module clkdiv_top(RST,CLKI,RELEASE,CDIV1,CDIV2,CDIV4,CDIV8);  
  
input  CLKI,RST,RELEASE;  
output CDIV1,CDIV2,CDIV4,CDIV8;  
  
CLKDIVB CLKDIBinst0 (.RST(RST),.CLKI(CLKI),.RELEASE(RELEASE),  
                   .CDIV1(CDIV1),.CDIV2(CDIV2),.CDIV4(CDIV4),.CDIV8(CDIV8));  
  
defparam CLKDIBint0.GSR = "DISABLED";  
  
endmodule
```

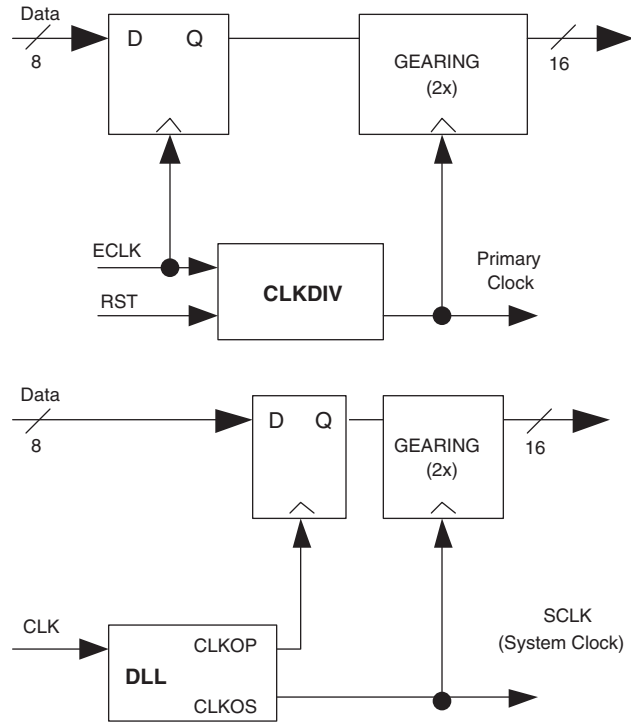
CLKDIV Example Circuits

The clock divider (CLKDIV) can divide a clock by 2 or 4 and drives a primary clock network. The clock dividers are useful for providing the low-speed FPGA clocks for I/O shift registers (x2, x4) and DDR (x2, x4) I/O logic interfaces. Divide by 8 is provided for slow speed/low power operation.

To guarantee a synchronous transfer in the I/O logic, the CLKDIV input clock must come from an edge clock and the output drives a primary clock. In this case, they are phase matched. This is especially useful for synchronously resetting the I/O logic when Mux/DeMux gearing is used in order to synchronize the entire data bus as shown in Figure 10-23. Using the low skew characteristics of the edge clock routing, a reset can be provided to all bits of the data bus to synchronize the Mux/DeMux gearing.

The second circuit shows that a DLL can replace CLKDIV for x2 and x4 applications.

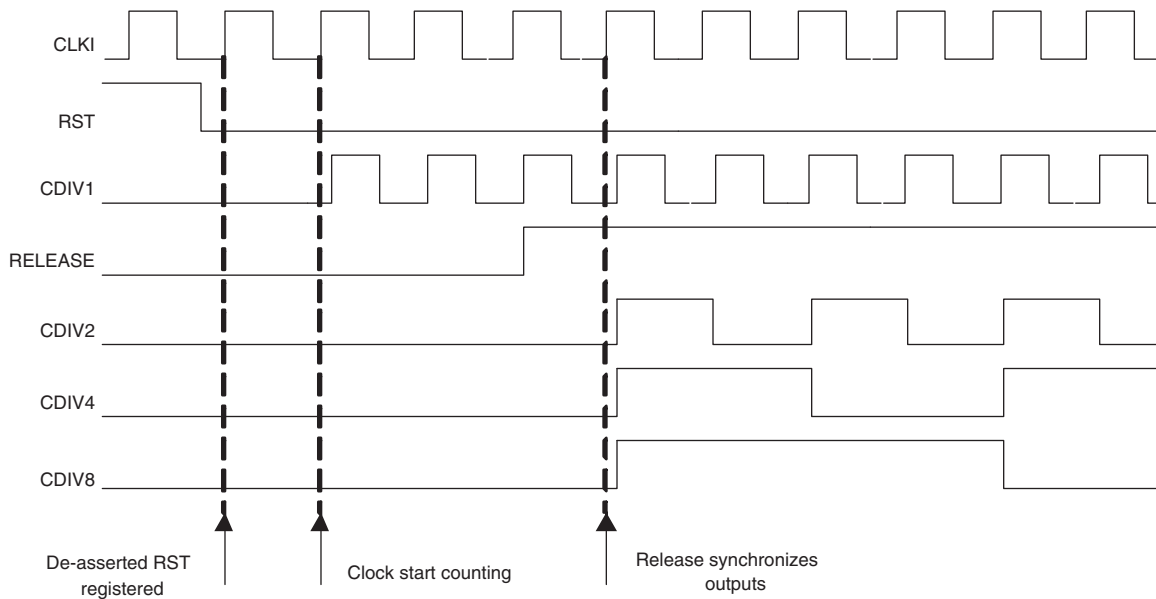
Figure 10-23. CLKDIV Application Examples



Release Behavior

The port “Release” is used to synchronize all outputs after RST is de-asserted. Figure 10-24 illustrates the Release behavior.

Figure 10-24. CLKDIV Release Behavior



DLLDEL (Slave Delay Line)

The Slave Delay line is designed to generate the desired delay in DDR/SPI4 applications. The delay control inputs (DCNTL[8:0]) are fed from the general purpose DLL outputs. The library element definitions are described in Figure 10-25 and Table 10-13.

Figure 10-25. DLLDELA Library Symbol

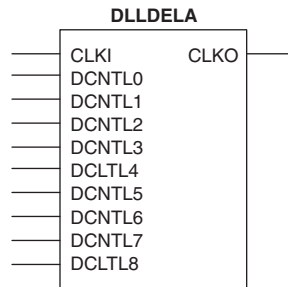


Table 10-13. DLLDELA I/O

| Name | I/O | Description |
|------------|-----|--------------------|
| CLKI | I | Clock Input |
| DCNTL[8:0] | I | Delay Control Bits |
| CLKO | O | Clock Output |

DLLDELA Declaration in VHDL Source Code

```

COMPONENT DLLDELA
  PORT
    (
      CLKI :IN std_logic;
      DCNTL0 :IN std_logic;
      DCNTL1 :IN std_logic;
      DCNTL2 :IN std_logic;
      DCNTL3 :IN std_logic;
      DCNTL4 :IN std_logic;
      DCNTL5 :IN std_logic;
      DCNTL6 :IN std_logic;
      DCNTL7 :IN std_logic;
      DCNTL8 :IN std_logic;
      CLKO :OUT std_logic
    );
END COMPONENT;

begin
  DLLDELAinst0: DLLDELA1
    PORT MAP (
      CLKI => clkisig,
      DCNTL0 => dcntl0sig,
      DCNTL1 => dcntl1sig,
      DCNTL2 => dcntl2sig,
      DCNTL3 => dcntl3sig,
      DCNTL4 => dcntl4sig,
      DCNTL5 => dcntl5sig,
      DCNTL6 => dcntl6sig,
      DCNTL7 => dcntl7sig,
      DCNTL8 => dcntl8sig,
    );
end;

```

```
        CLKO => clkosig
    );
```

```
end
```

DLLDELA Usage with TRDLLA - Verilog - Example

Note: DLL0(TRDLLA) must be generated by IPexpress as a sub-module

```
module dddl_top (rst,d,clkkin,clkkin2,clkout,aluhold,uddcntl,q);

input rst,d,clkkin,clkkin2,aluhold,uddcntl;
output clkout,q;

wire [8:0]DCntl_int;
reg qint;

DLL0 dllinst0 (.clk(clkkin2), .aluhold(aluhold), .uddcntl(uddcntl), .clkop(),
    .clkos(),
    .dcntl(DCntl_int),.lock());
DLLDELA delinst0 (.CLKI(clkkin),.DCNTL0(DCntl_int[0]),.DCNTL1(DCntl_int[1]),
    .DCNTL2(DCntl_int[2]), .DCNTL3(DCntl_int[3]), .DCNTL4(DCntl_int[4]),
    .DCNTL5(DCntl_int[5]), .DCNTL6(DCntl_int[6]), .DCNTL7(DCntl_int[7]),
    .DCNTL8(DCntl_int[8]), .CLKO(clk90)); //synthesis syn_black_box

assign clkout = clk90;
assign q = qint;

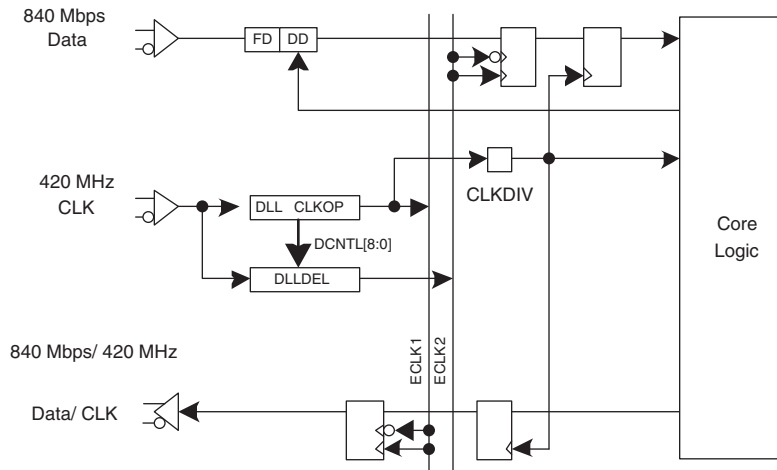
always@(posedge clk90 or negedge rst)
    if (~rst)
        qint =1'b0;
    else
        qint = d;

endmodule
```

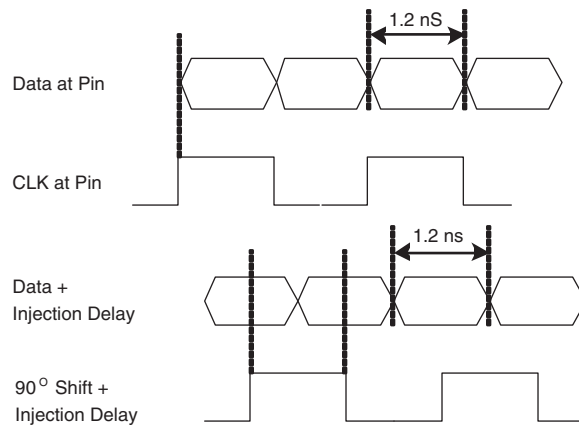
DLLDELA Application Example

Figure 10-26 shows an example DLLDEL application. As shown in the timing diagram, DLLDEL shifts the clock by 90 degrees to center both edges in the middle of data window.

Figure 10-26. SPI4.2 and DDR Registers Interface Application



FD: Fixed Delay
DD: Dynamic Delay
Users can select the delay setting in IPExpress.



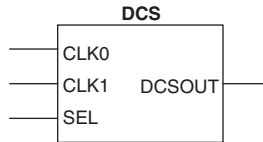
DQSDLL and DQSDEL

There is another combination of DLL and Slave Delay Line, DQSDLL and DQSDEL, in the LatticeECP2/M device family. This pair is similar in design and function to DLL and DLLDEL, but usage is limited to DDR implementation. For additional information, see TN1102, [LatticeECP2/M sysIO Usage Guide](#).

DCS (Dynamic Clock Select)

DCS is a global clock buffer incorporating a smart multiplexer function that takes two independent input clock sources and avoids glitches or runt pulses on the output clock, regardless of where the enable signal is toggled. There are two DCSs for each quadrant. The outputs of the DCS then reach primary clock distribution via the feed-lines. Figure 10-27 shows the block diagram of the DCS.

Figure 10-27. DCS Library Symbol



DCS Library Element Definition

Table 10-14 defines the I/O ports of the DCS block. There are eight modes available. Table 10-15 describes how each mode is configured.

Table 10-14. DCS I/O Definition

| I/O | Name | Description |
|--------|--------|--------------------|
| Input | SEL | Input Clock Select |
| | CLK0 | Clock input 0 |
| | CLK1 | Clock Input 1 |
| Output | DCSOUT | Clock Output |

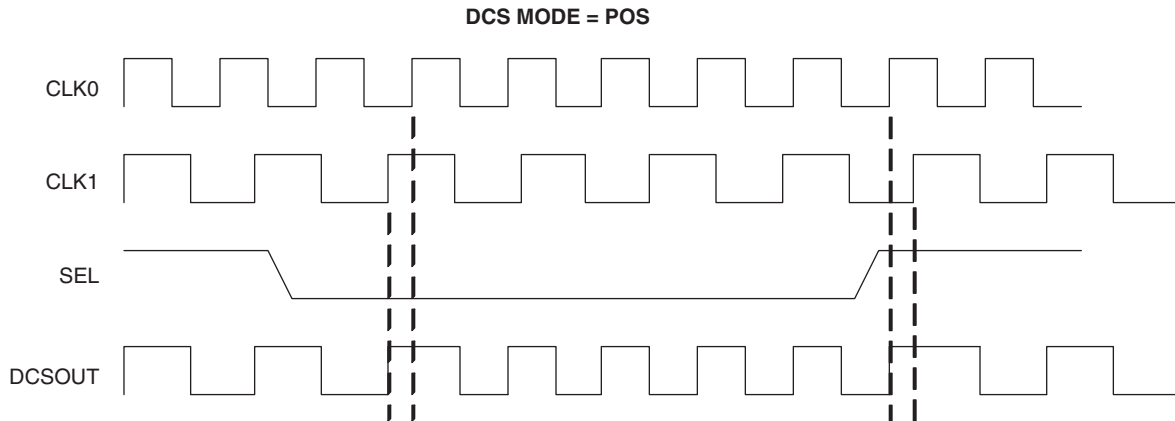
Table 10-15. DCS Modes of Operations

| Attribute Name | Description | Output | | Value |
|----------------|--|---------|---------|-----------|
| | | SEL = 0 | SEL = 1 | |
| DCS MODE | Rising edge triggered, latched state is high | CLK0 | CLK1 | POS |
| | Falling edge triggered, latched state is low | CLK0 | CLK1 | NEG |
| | Sel is active high, disabled output is low | 0 | CLK1 | HIGH_LOW |
| | Sel is active high, disabled output is high | 1 | CLK1 | HIGH_HIGH |
| | Sel is active low, disabled output is low | CLK0 | 0 | LOW_LOW |
| | Sel is active low, disabled output is high | CLK0 | 1 | LOW_HIGH |
| | Buffer for CLK0 | CLK0 | CLK0 | CLK0 |
| | Buffer for CLK1 | CLK1 | CLK1 | CLK1 |

DCS Timing Diagrams

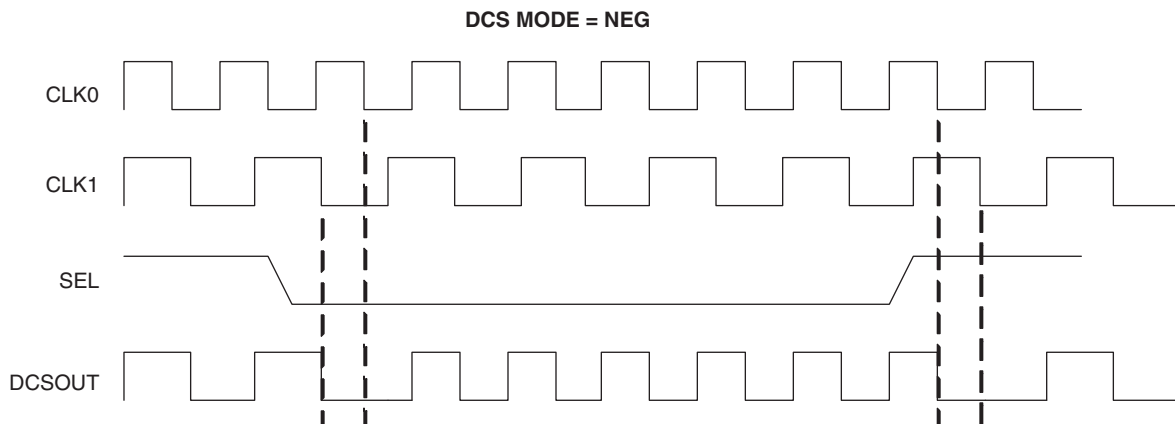
Each mode performs its unique operation. Clock output timing is determined by input clocks and the edge of the SEL signal. Figure 10-28 describes the timing of each mode.

Figure 10-28. Timing Diagrams by DCS MODE



- SEL Falling edge:**
- Wait for CLK1 rising edge, latch output & remain high
 - Switch output at CLK0 rising edge

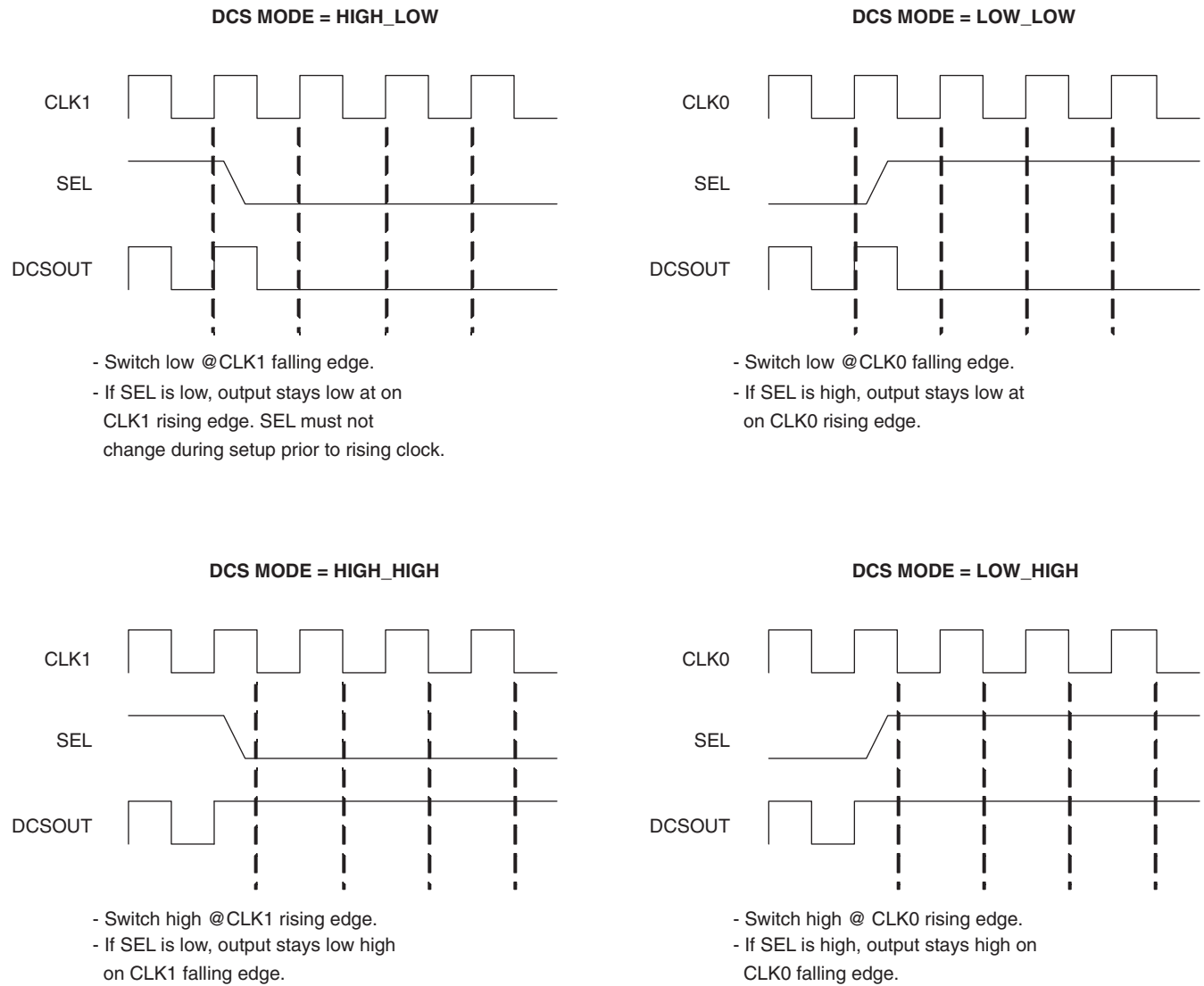
- SEL Rising edge:**
- Wait for CLK0 rising edge, latch output & remain high
 - Switch output at CLK1 rising edge



- SEL Falling edge:**
- Wait for CLK1 falling edge, latch output & remain low
 - Switch output at CLK0 falling edge

- SEL Rising edge:**
- Wait for CLK0 falling edge, latch output & remain low
 - Switch output at CLK1 falling edge

Figure 10-28. Timing Diagrams by DCS MODE (Cont.)



DCS Usage with VHDL - Example

```
library ecp2m;
use ecp2m.components.all;
library IEEE;
use IEEE.std_logic_1164.all;

entity DCStest is port
( clksel  : in  std_logic;
  dcsclk0 : in  std_logic;
  sysclk1 : in  std_logic;
  dcsclk  : out std_logic
);
end DCStest;
architecture DCStest_arch of DCStest is
  COMPONENT DCS
    -- synthesis translate_off
    GENERIC
    ( DCSMODE : string := "POS"
    );
    -- synthesis translate_on
    PORT
    ( CLK0   :IN  std_logic;
      CLK1   :IN  std_logic;
      SEL    :IN  std_logic;
      DCSOUT :OUT std_logic
    );
  END COMPONENT;

  attribute DCSMODE          : string;
  attribute DCSMODE of DCSinst0 : label is "POS";

begin
  DCSinst0: DCS
    -- synthesis translate_off
    GENERIC MAP
    ( DCSMODE => "POS"
    )
    -- synthesis translate_on
    PORT MAP
    ( SEL    => clksel,
      CLK0   => dcsclk0,
      CLK1   => sysclk1,
      DCSOUT => dcsclk
    );
end DCStest_arch;
```

DCS Usage with Verilog - Example

```
module dcs(clk0,clk1,sel,dcscout);

input clk0, clk1, sel;
output dcscout;

DCS DCSInst0 (.SEL(sel), .CLK0(clk0), .CLK1(clk1), .DCSOUT(dcscout));
defparam DCSInst0.DCSMODE = "CLK0";

endmodule
```

Oscillator (OSCD)

There is a dedicated oscillator in the LatticeECP2/M devices whose output is made available for users. The oscillator frequency is programmable with a range of 2.5 to 130MHz. The output of the oscillator can also be routed as an input clock to the clock tree. The oscillator frequency output can be further divided by internal logic (user logic) for lower frequencies, if desired. The oscillator is powered down when not in use. The output of this oscillator is not a precision clock. It is intended for use as an extra clock that does not require accurate clocking.

Library Element Name: OSCD

Table 10-16. OSCD Port Definition

| I/O | Name | Description |
|--------|------|-------------------------|
| Output | OSC | Oscillator Clock Output |

Table 10-17. OSCD Attribute Definition

| User Attribute | Attribute Name | Value (MHz) | Default Value |
|-------------------|----------------|---|---------------|
| Nominal Frequency | NOM_FREQ | 2.5, 4.3, 5.4, 6.9, 8.1, 9.2, 10.0, 13.0, 15.0, 20.0, 26.0, 30.0, 34.0, 41.0, 45.0, 55.0, 60.0, 130.0 | 2.5 |

Please refer to the [LatticeECP2/M Family Data Sheet](#) for detailed specifications.

OSC Library Symbol (OSCD)

Figure 10-29. OCS Symbol



OSC Usage with VHDL - Example

```
COMPONENT OSCD
-- synthesis translate_off
    GENERIC(NOM_FREQ: string);
-- synthesis translate_on
PORT (CFGCLK:OUT    std_logic);

END COMPONENT;

    attribute NOM_FREQ : string;
    attribute NOM_FREQ of OSCins0 : label is "2.5";
begin

OSCInst0: OSCD
-- synthesis translate_off
    GENERIC MAP (NOM_FREQ => "2.5")
-- synthesis translate_on
    PORT MAP ( CFGCLK=>    osc_int);

end
```

OSC Usage with Verilog - Example

```
module OSC_TOP(OSC_CLK);

output OSC_CLK;

OSCD OSCinst0 (.CFGCLK(OSC_CLK));

defparam OSCinst0.NOM_FREQ = "2.5";

endmodule
```

Input Clock Sharing

The reference clock from the pads can be shared in LatticeECP2/M PLLS and DLLS as shown in Figures 10-30 and 10-31. This feature is useful when only one clock source is available for multiple PLLs/DLLs.

Figure 10-30. Input Clock Sharing (LatticeECP2-50 and LatticeECP2-70)

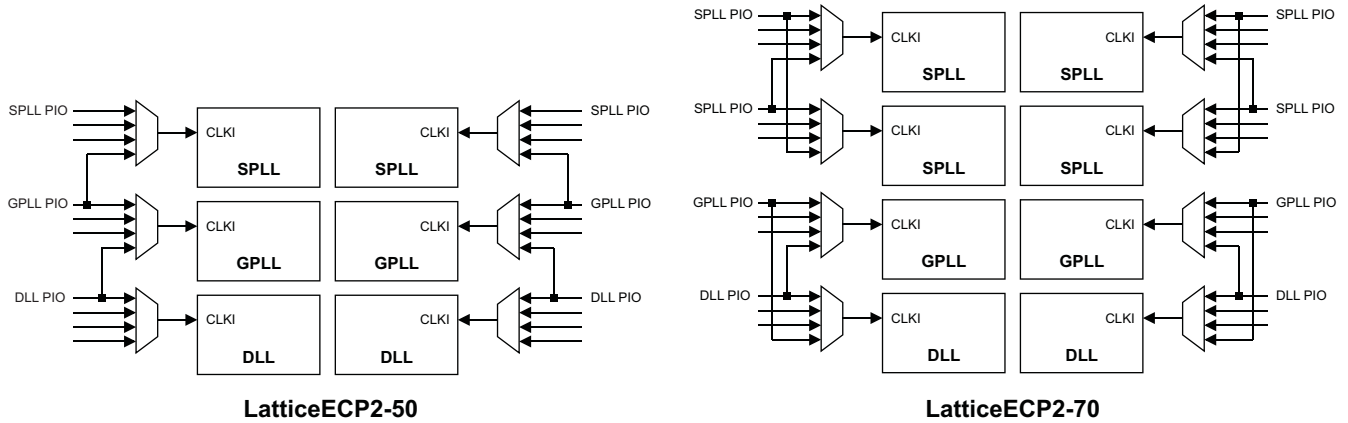
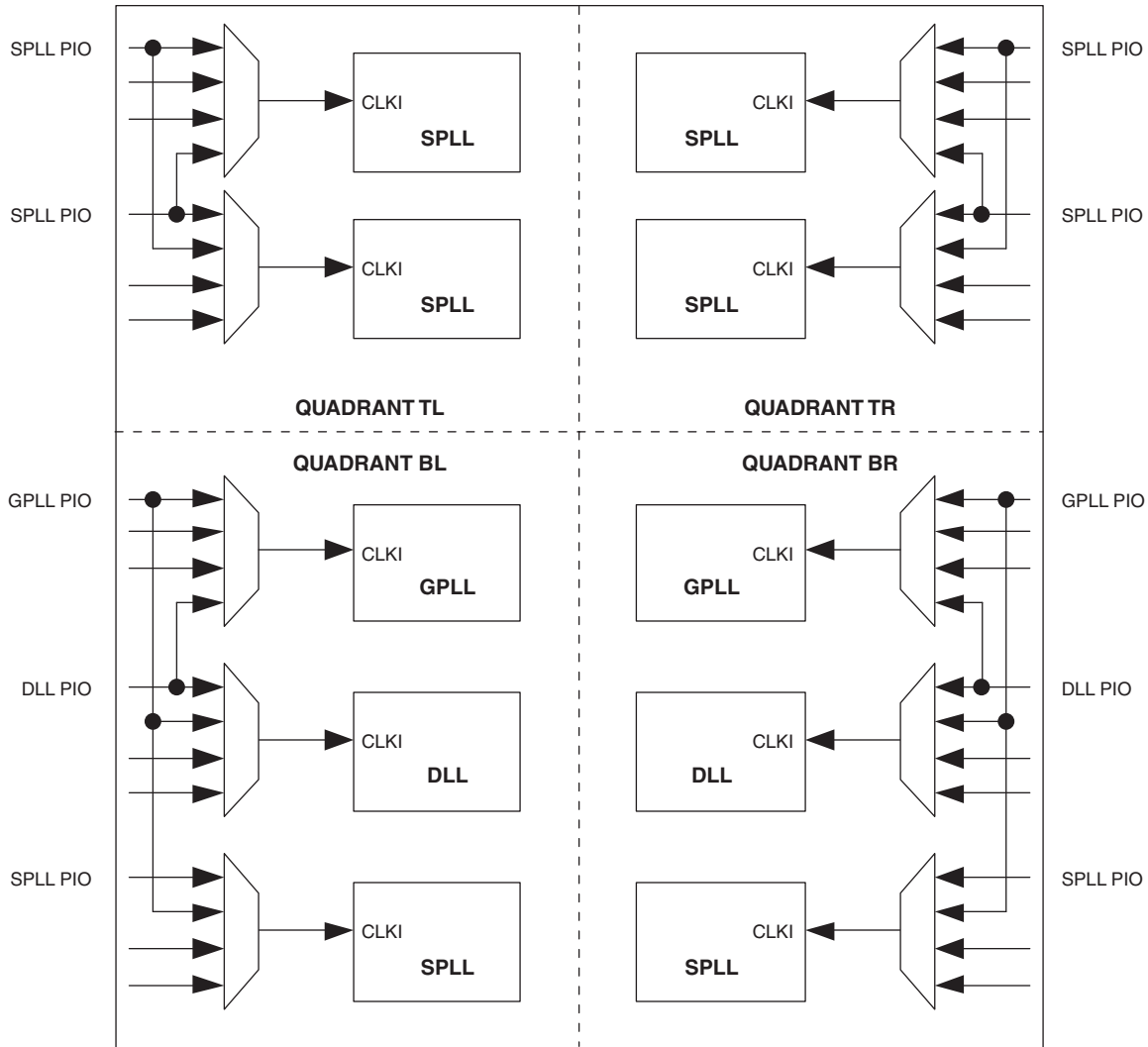


Figure 10-31. Input Clock Sharing (LatticeECP2M with Six SPLLs)



Setting Clock Preferences

Clock preferences allow designers to implement clocks to the desired performance. Preferences can be set in the ispLEVER Design Planner Spreadsheet View (or **Tools > Spreadsheet View** in Diamond) or in preference files. Frequently used preferences are described in Appendix C. For additional information see the ispLEVER or Diamond on-line Help system.

Power Supplies

Each PLL has its own power supply. On the LatticeECP2-6, LatticeECP2-12, and LatticeECP2-20 devices the PLL power supply has been combined with the package VCC for better performance. There will only be VCC pins on these devices.

On the larger LatticeECP2 and all LatticeECP2M devices, the PLL power supply has its own power supply pins, VCCPLL. Since VCC and VCCPLL are normally the same 1.2V, it is recommended that they are driven from the same power supply on the circuit board, thus minimizing leakage. In addition, each of these supplies should be independently isolated from the main 1.2V supply on the board using proper board filtering techniques to minimize the noise coupling between them.

The DLL is powered from the FPGA core power supply.

Technical Support Assistance

Hotline: 1-800-LATTICE (North America)
+1-503-268-8001 (Outside North America)
e-mail: techsupport@latticesemi.com
Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|---------------------------------|---------|---|
| February 2006 | 01.0 | Initial release. |
| April 2006 | 01.1 | Removed unsupported devices, removed DLL SMI phrases, rephrased DDUTY support due to software incomplete. |
| September 2006 | 01.2 | Added detailed clock network descriptions. |
| | | Added IPexpress GUI quick reference table. |
| | | Added LatticeECP2M information throughout. |
| | | OSC divider value range updated. |
| January 2007 | 01.3 | Updated Frequency range. |
| | | Described CLKOP and CLKOK synchronous timing relationship with respective reset signals. |
| January 2007 | 01.4 | Updated IPexpress Main Window screen shot. |
| | | Updated LatticeECP2/M Configuration Tab screen shot. |
| | | Updated User Parameters in the Configuration GUI table. |
| June 2007 | 01.5 | Corrected reference to EXHPLLD in Optional External Capacitor section (changed to EHXPLLD). |
| | | Updated GSR section of Attributes. |
| August 2008 | 01.6 | Updated the LatticeECP2/M PLL Configuration tab screen shot. |
| | | Updated the Port names for the LatticeECP2/M PLL Library symbols. |
| | | Added LatticeECP2/M PLL Modules section. |
| | | Corrected the External Capacitor section. |
| | | Removed the DLL operation mode CIMDLLA since it is not available on LatticeECP2/M. |
| Updated Power Supplies section. | | |
| March 2009 | 01.7 | Updated "DCS Usage with VHDL - Example" code. |
| October 2009 | 01.8 | Updated Input Clock Sharing (LatticeECP2-50 and LatticeECP2-70) figure. |
| February 2010 | 01.9 | Reconciled LOCK description among MachXO, LatticeXP2, LatticeECP2/M and LatticeECP3. |
| May 2010 | 02.0 | Specified dedicated clock pins in the Secondary Clocks text section. |
| June 2010 | 02.1 | Updated for Lattice Diamond design software support. |

Appendix A. Primary Clock Sources and Distribution

Figure 10-32. LatticeECP2 Primary Clock Sources and Distribution

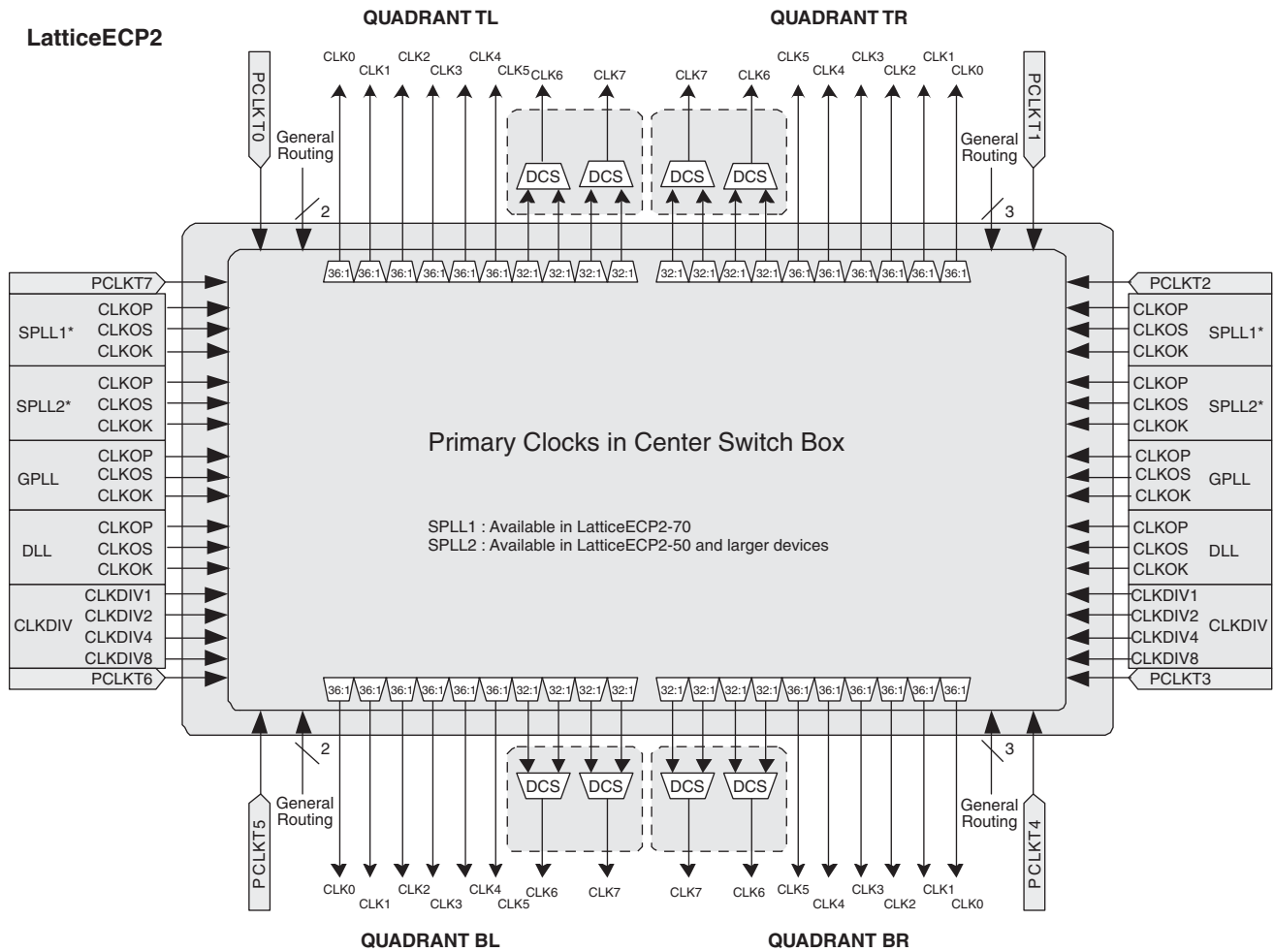


Figure 10-33. LatticeECP2 Primary Clock Muxes

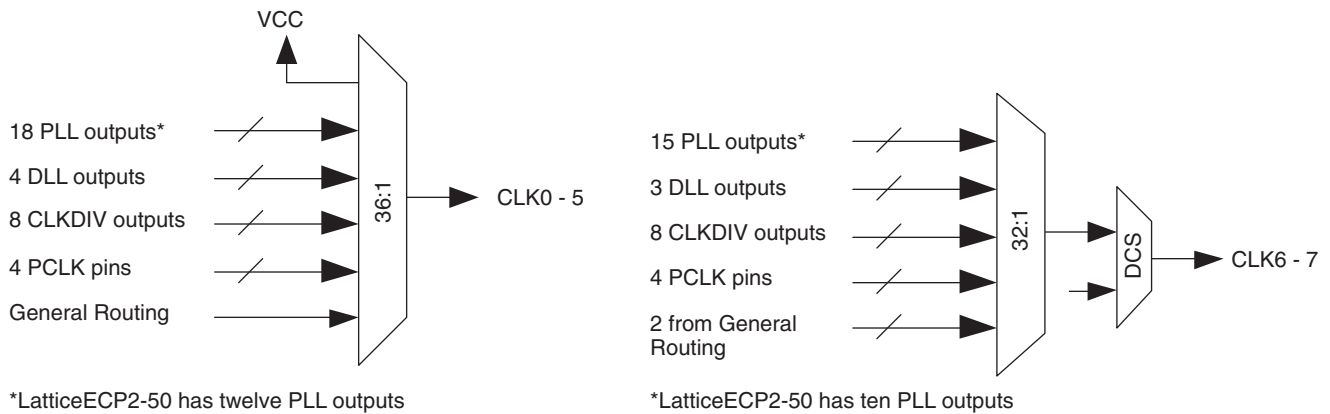


Figure 10-34. LatticeECP2M Primary Clock Sources and Distribution

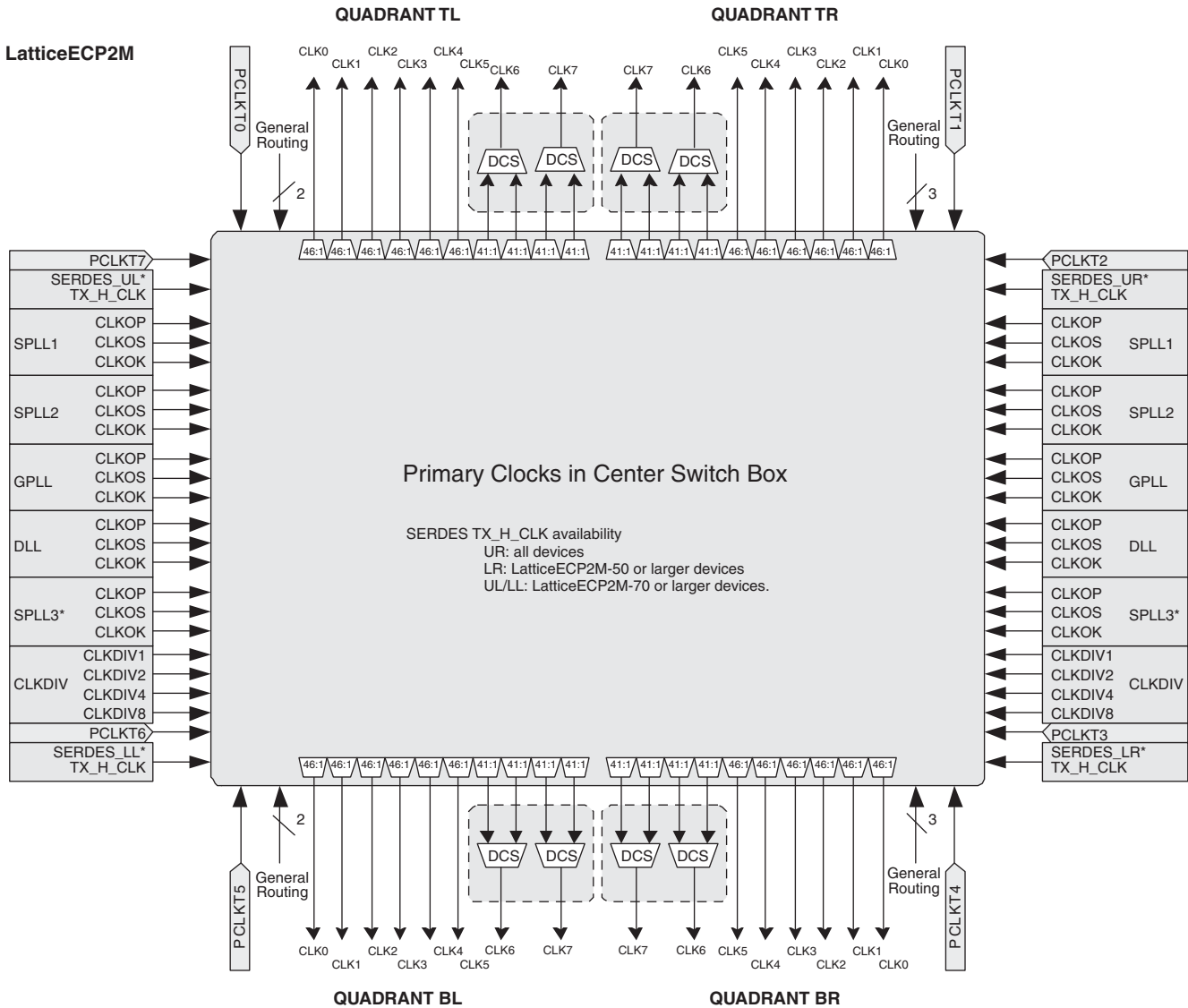
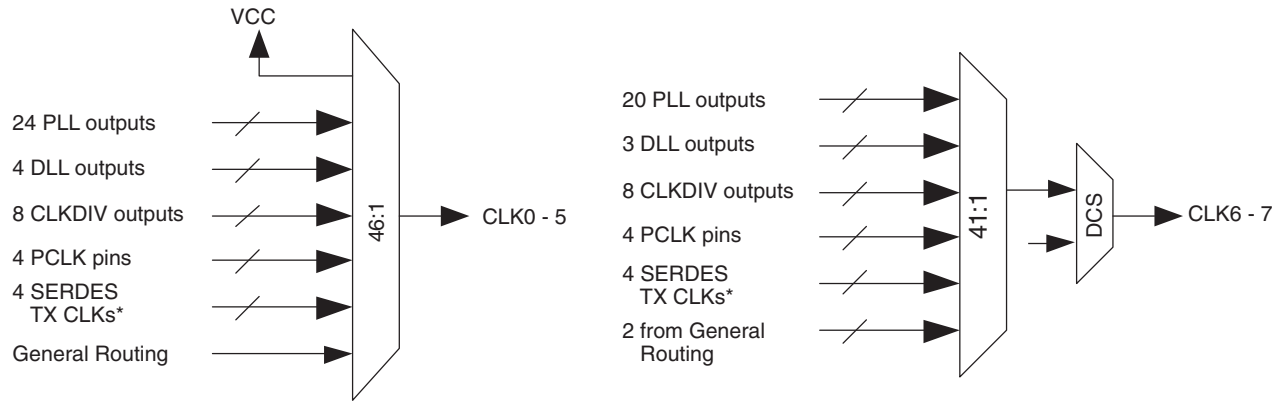


Figure 10-35. LatticeECP2M Primary Clock Muxes

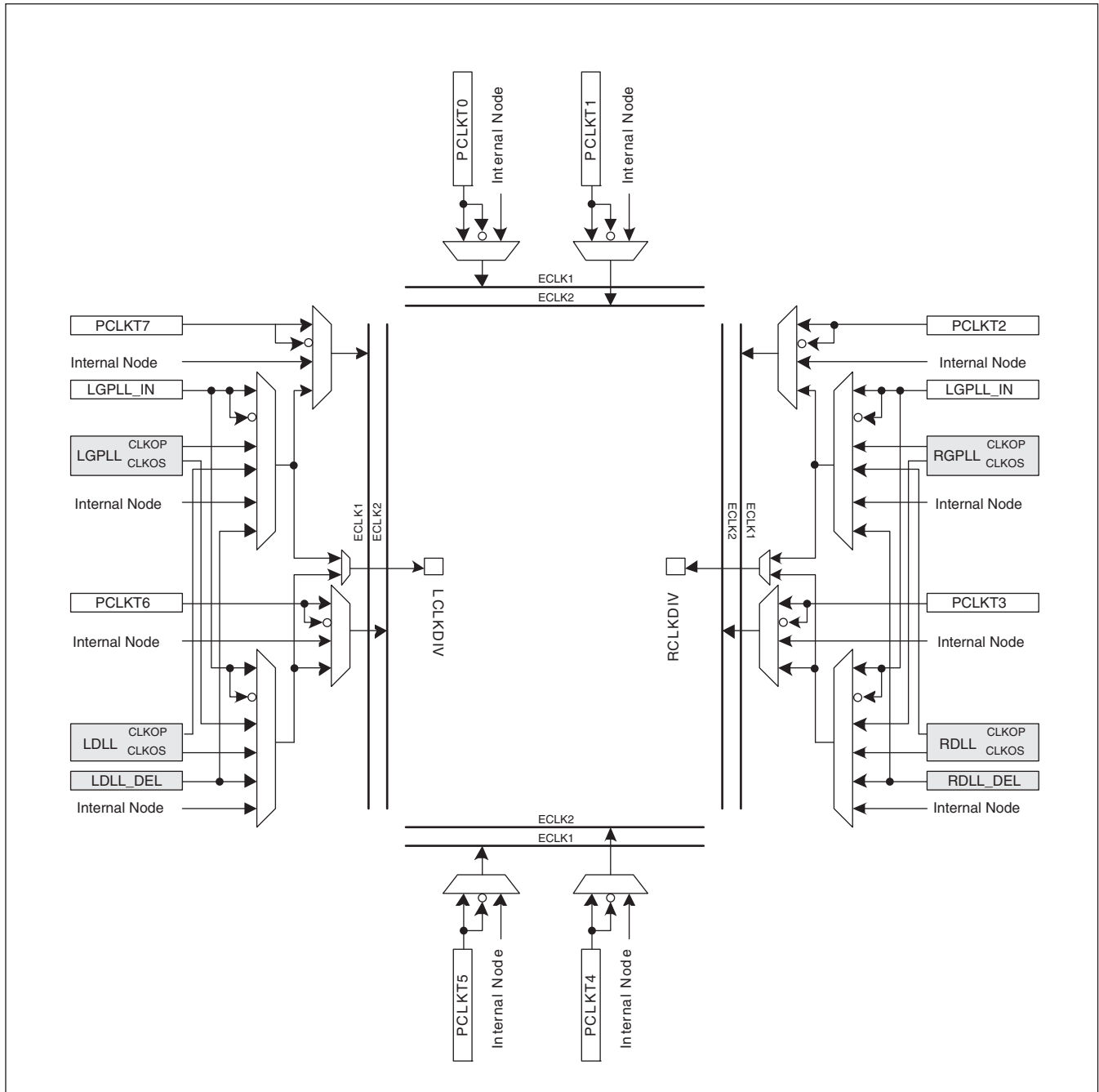


*LatticeECP2M-50 has two SERDES TX CLK outputs

Appendix B. PLL, DLL, CLKIDV and ECLK Locations and Connectivity

Figure 10-36 shows the locations, site names, and connectivity of the PLLs, DLLs, CLKIDVs and ECLKs

Figure 10-36. PLL, DLL, CLKIDV and ECLK Locations and Connectivity



Appendix C. Clock Preferences

A few key clock preferences are introduced below. Refer to the software “Help” file for other preferences and detailed information.

ASIC

The following preference command assigns a phase of 90° to the TRDLLA_CLKOS:

```
ASIC "my_dll" TYPE "TRDLLA" CLKOS_PHASE=90;
```

FREQUENCY

The following physical preference command assigns a frequency of 100 MHz to a net named clk1:

```
FREQUENCY NET "clk1" 100 MHz;
```

The following preference specifies a hold margin value for each clock domain:

```
FREQUENCY NET "RX_CLKA_CMOS_c" 100.000 MHz HOLD_MARGIN 1 ns;
```

MAXSKEW

The following command assigns a maximum skew of 5ns to a net named NetB:

```
MAXSKEW NET "NetB" 5 NS;
```

MULTICYCLE

The following command will relax the period to 50ns for the path starting at COMPA to COMPB (NET1):

```
MULTICYCLE "PATH1" START COMP "COMPA" END COMP "COMPB" NET "NET1" 50 NS ;
```

PERIOD

The following command assigns a clock period of 30ns to the port named Clk1:

```
PERIOD PORT "Clk1" 30 NS;
```

PROHIBIT

This command prohibits the use of a primary clock to route a clock net named bf_clk:

```
PROHIBIT PRIMARY NET "bf_clk";
```

USE PRIMARY

Use a primary clock resource to route the specified net.

```
USE PRIMARY NET clk_fast;  
USE PRIMARY DCS NET "bf_clk";  
USE PRIMARY PURE NET "bf_clk" QUADRANT_TL;
```

USE SECONDARY

Use a secondary clock resource to route the specified net.

```
USE SECONDARY NET "clk_lessfast" QUADRANT_TL;
```

USE EDGE

Use an edge clock resource to route the specified net.

```
USE EDGE NET "clk_fast";
```

CLOCK_TO_OUT

Specifies a maximum allowable output delay relative to a clock.

Lattice Semiconductor

Here are two preferences using both the CLKPORT and CLKNET keywords showing the corresponding scope of TRACE reporting.

The CLKNET will stop tracing the path before the PLL, so you will not get PLL compensation timing numbers.

```
CLOCK_TO_OUT PORT "RxAddr_0" 6.000000 ns CLKNET "pll_rxclk" ;
```

The above preference will yield the following clock path:

Physical Path Details:

Clock path pll_inst/pll_utp_0_0 to PFU_33:

| Name | Fanout | Delay (ns) | Site | Resource |
|-------|--------|------------|---|----------------------|
| ROUTE | 49 | 2.892 | ULPPLL.MCLK to | R3C14.CLK0 pll_rxclk |
| ----- | | | | |
| | | 2.892 | (0.0% logic, 100.0% route), 0 logic levels. | |

If CLKPORT is used, the trace is complete back to the clock port resource and provides PLL compensation timing numbers.

```
CLOCK_TO_OUT PORT "RxAddr_0" 6.000000 ns CLKPORT "RxClk" ;
```

The above preference will yield the following clock path:

Clock path RxClk to PFU_33:

| Name | Fanout | Delay (ns) | Site | Resource |
|----------|--------|------------|---|----------------------------------|
| IN_DEL | --- | 1.431 | D5.PAD to | D5.INCK RxClk |
| ROUTE | 1 | 0.843 | D5.INCK to | ULPPLL.CLKIN RxClk_c |
| MCLK_DEL | --- | 3.605 | ULPPLL.CLKIN to | ULPPLL.MCLK pll_inst/pll_utp_0_0 |
| ROUTE | 49 | 2.892 | ULPPLL.MCLK to | R3C14.CLK0 pll_rxclk |
| ----- | | | | |
| | | 8.771 | (57.4% logic, 42.6% route), 2 logic levels. | |

INPUT_SETUP

Specifies an setup time requirement for input ports relative to a clock net.

```
INPUT_SETUP PORT "datain" 2.000000 ns HOLD 1.000000 ns CLKPORT "clk"  
PLL_PHASE_BACK ;
```

PLL_PHASE_BACK

This preference is used with INPUT_SETUP when the user needs a Trace calculation based on the previous clock edge.

This preference is useful when setting the PLL output Phase Adjustment. Since there is no negative phase adjustment provided, the PLL_PHASE_BACK preference works as if negative phase adjustment is available.

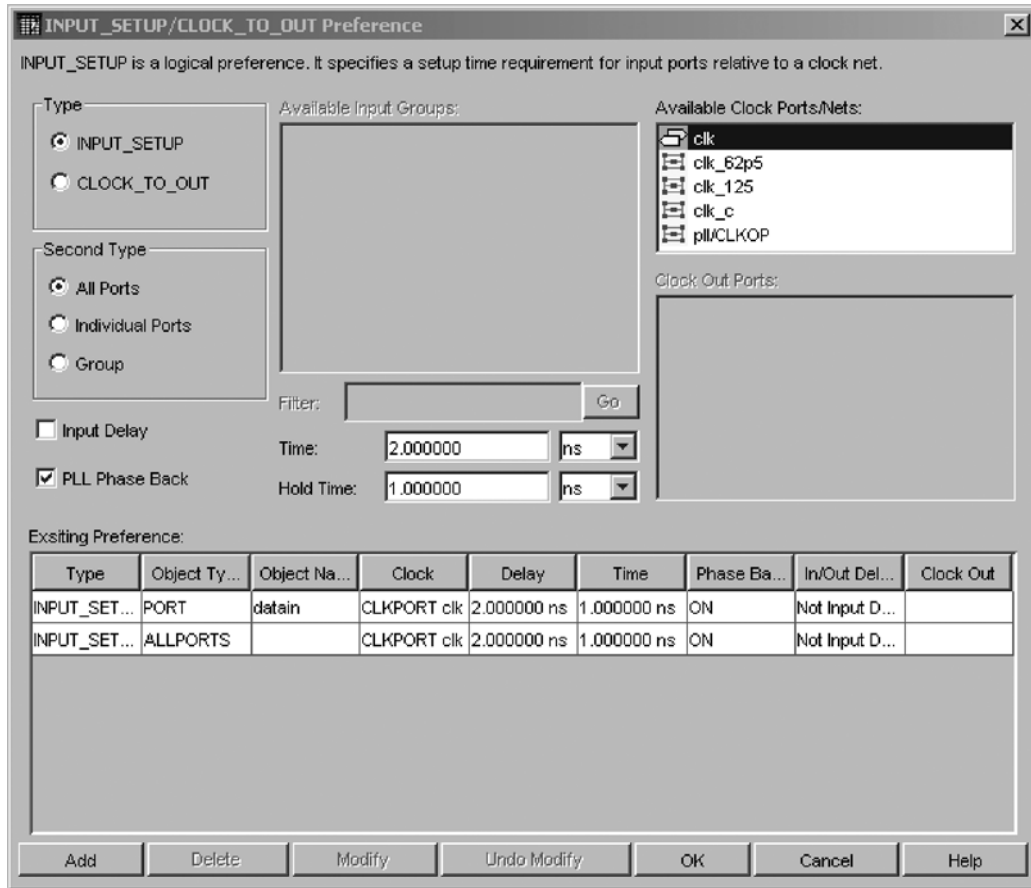
For example:

If a Phase Adjustment of -90° of CLKOS is desired, the user can set the Phase to 270° and set the INPUT_SETUP preference with PLL_PHASE_BACK.

PLL_PHASE_BACK Usage in Pre-Map Preference Editor: The Pre-Map Preference Editor can be used to set the PLL_PHASE_BACK attribute.

1. Open the Design Planner (Pre-Map).
2. In the Design Planner control window, select **Spreadsheet View** under **View**.
3. In the Spreadsheet View window, select **Input_setup/Clock_to_out...**
4. The INPUT_SETUP/CLOCK_TO_OUT Preference window is shown in Figure 10-37.

Figure 10-37. INPUT_SETUP/CLOCK_TO_OUT Preference Window (see Appendix D Figure 10-41 for Diamond Equivalent)



Appendix D. Lattice Diamond Usage Overview

This appendix discusses the use of Lattice Diamond design software for projects that include the LatticeECP2M SERDES/PCS module .

For general information about the use of Lattice Diamond, refer to the Lattice Diamond Tutorial.

If you have been using ispLEVER software for your FPGA design projects, Lattice Diamond may look like a big change. But if you look closer, you will find many similarities because Lattice Diamond is based on the same toolset and work flow as ispLEVER. The changes are intended to provide a simpler, more integrated, and more enhanced user interface.

Converting an ispLEVER Project to Lattice Diamond

Design projects created in ispLEVER can easily be imported into Lattice Diamond. The process is automatic except for the ispLEVER process properties, which are similar to the Diamond strategy settings, and PCS modules. After importing a project, you need to set up a strategy for it and regenerate any PCS modules.

Importing an ispLEVER Design Project

Make a backup copy of the ispLEVER project or make a new copy that will become the Diamond project.


1. In Diamond, choose **File > Open > Import ispLEVER Project**.
2. In the ispLEVER Project dialog box, browse to the project's .syn file and open it.
3. If desired, change the base file name or location for the Diamond project. If you change the location, the new Diamond files will go into the new location, but the original source files will not move or be copied. The Diamond project will reference the source files in the original location.

The project files are converted to Diamond format with the default strategy settings.

Adjusting PCS Modules

PCS modules created with IPexpress have an unusual file structure and need additional adjustment when importing a project from ispLEVER. There are two ways to do this adjustment. The preferred method is to regenerate the module in Diamond. However this may upgrade the module to a more recent version. An upgrade is usually desirable but if, for some reason, you do not want to upgrade the PCS module, you can manually adjust the module by copying its .txt file into the implementation folder. If you use this method, you must remember to copy the .txt file into any future implementation folders.

Regenerate PCS Modules

1. Find the PCS module in the Input Files folder of File List view. The module may be represented by an .lpc, .v, or .vhd file.
2. If the File List view shows the Verilog or VHDL file for the module, and you want to regenerate the module, import the module's .lpc file:
 - a. In the File List view, right-click the implementation folder () and choose **Add > Existing File**.
 - b. Browse for the module's .lpc file, **<module_name>.lpc**, and select it.
 - c. Click **Add**. The .lpc file is added to the File List view.
 - d. Right-click the module's Verilog or VHDL file and choose **Remove**.
3. In File List, double-click the module's .lpc file. The module's IPexpress dialog box opens.
4. In the bottom of the dialog box, click **Generate**. The Generate Log tab is displayed. Check for errors and close.

In File List, the .lpc file is replaced with an .lpx file. The IPexpress manifest (.lpx) file is new with Diamond. The .lpx file keeps track of the files needed for complex modules.

Using IPexpress with Lattice Diamond

Using IPexpress with Lattice Diamond is essentially same as with ispLEVER.

The configuration GUI tabs are all the same except for the Generation Options tab. Figure 10-38 shows the Generation Options tab window.

Figure 10-38. Generation Options Tab

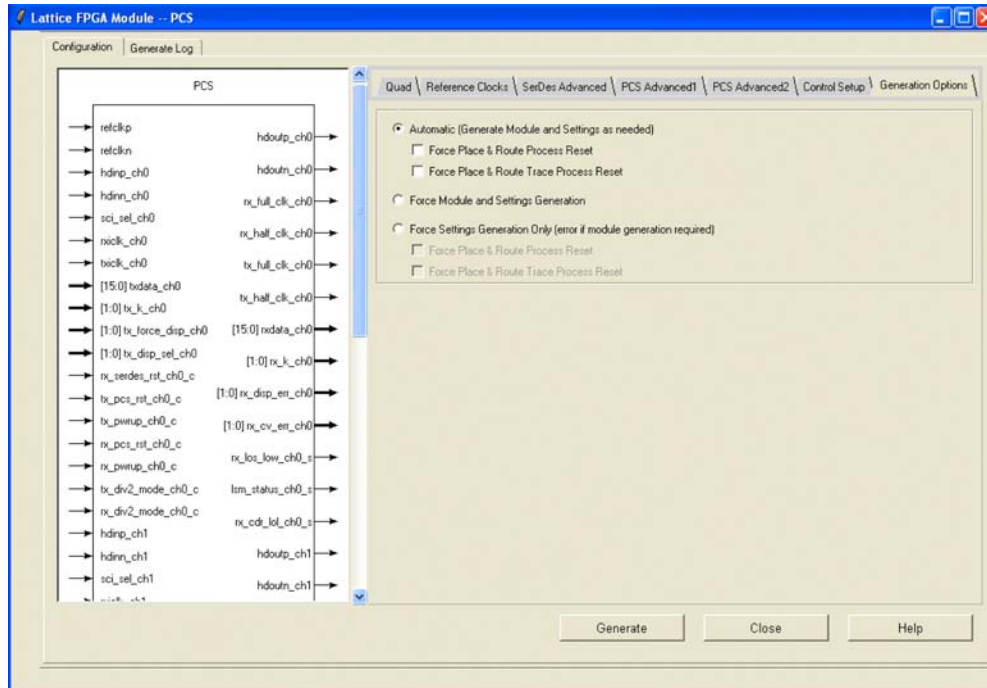


Table 10-18. SERDES_PCS GUI Attributes – Generation Options Tab

| GUI Text | Description |
|---|---|
| Automatic | Automatically generates the HDL and configuration(.txt) files as needed. Some changes do not require regenerating both files. |
| Force Module and Settings Generation | Generates both the HDL and configuration files. |
| Force Settings Generation Only | Generates only the attributes file. You get an error message if the HDL file also needs to be generated. |
| Force Place & Route Process Reset | Resets the Place & Route Design process, forcing it to be run again with the newly generated PCS module. |
| Force Place & Route Trace Process Reset | Resets the Place & Route Trace process, forcing it to be run again with the newly generated PCS module. |

Note:

Automatic is set as the default option. If either Automatic or Force Settings Generation Only and no sub-options (Process Reset Options) are checked and the HDL module is not generated, the reset pointer is set to Bitstream generation automatically.

After the Generation is finished, the reset marks in the process window will be reset accordingly.

Creating a New Simulation Project Using Simulation Wizard

This section describes how to use the Simulation Wizard to create a simulation project (.spf) file so you can import it into a standalone simulator.

1. In Project Navigator, click **Tools > Simulation Wizard**. The Simulation Wizard opens.
2. In the Preparing the Simulator Interface page click **Next**.
3. In the Simulator Project Name page, enter the name of your project in the Project Name text box and browse to the file path location where you want to put your simulation project using the Project Location text box and Browse button.

When you designate a project name in this wizard page, a corresponding folder will be created in the file path you choose. Click **Yes** in the popup dialog that asks you if you wish to create a new folder.

4. Click either the Active-HDL[®] or ModelSim[®] simulator check box and click **Next**.
5. In the Process Stage page choose which type of Process Stage of simulation project you wish to create. Valid types are RTL, Post-Synthesis Gate-Level, Post-Map Gate-Level, and Post-Route Gate-level+Timing. Only those process stages that are available are activated.

Note that you can make a new selection for the current strategy if you have more than one defined in your project.

The software supports multiple strategies per project implementation which allow you to experiment with alternative optimization options across a common set of source files. Since each strategy may have been processed to different stages, this dialog allows you to specify which stage you wish to load.

6. In the Add Source page, select from the source files listed in the Source Files list box or use the browse button on the right to choose another desired source file. Note that if you wish to keep the source files in the local simulation project directory you just created, check the **Copy Source to Simulation Directory** option.
7. Click **Next** and a Summary page appears and provides information on the project selections including the simulation libraries. By default, the Run Simulator check box is enabled and will launch the simulation tool you chose earlier in the wizard in the Simulator Project Name page.
8. Click **Finish**.

The Simulation Wizard Project (.spf) file and a simulation script DO file are generated after running the wizard. You can import the DO file into your current project if desired. If you are using Active-HDL, the wizard will generate an .ado file and if you are using ModelSim, it creates and .mdo file.

Note: PCS configuration file, (.txt) must be added in step 6.

Figure 10-39. Diamond Spreadsheet View (see Figure 10-5 for ispLEVER Equivalent)

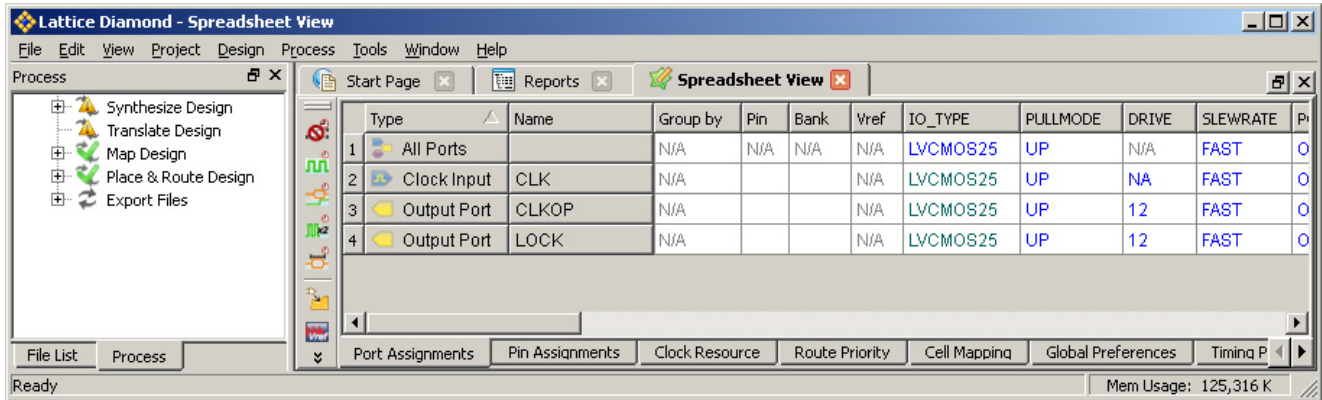


Figure 10-40. Diamond IPexpress Main Window (see Figure 10-14 for ispLEVER Equivalent)

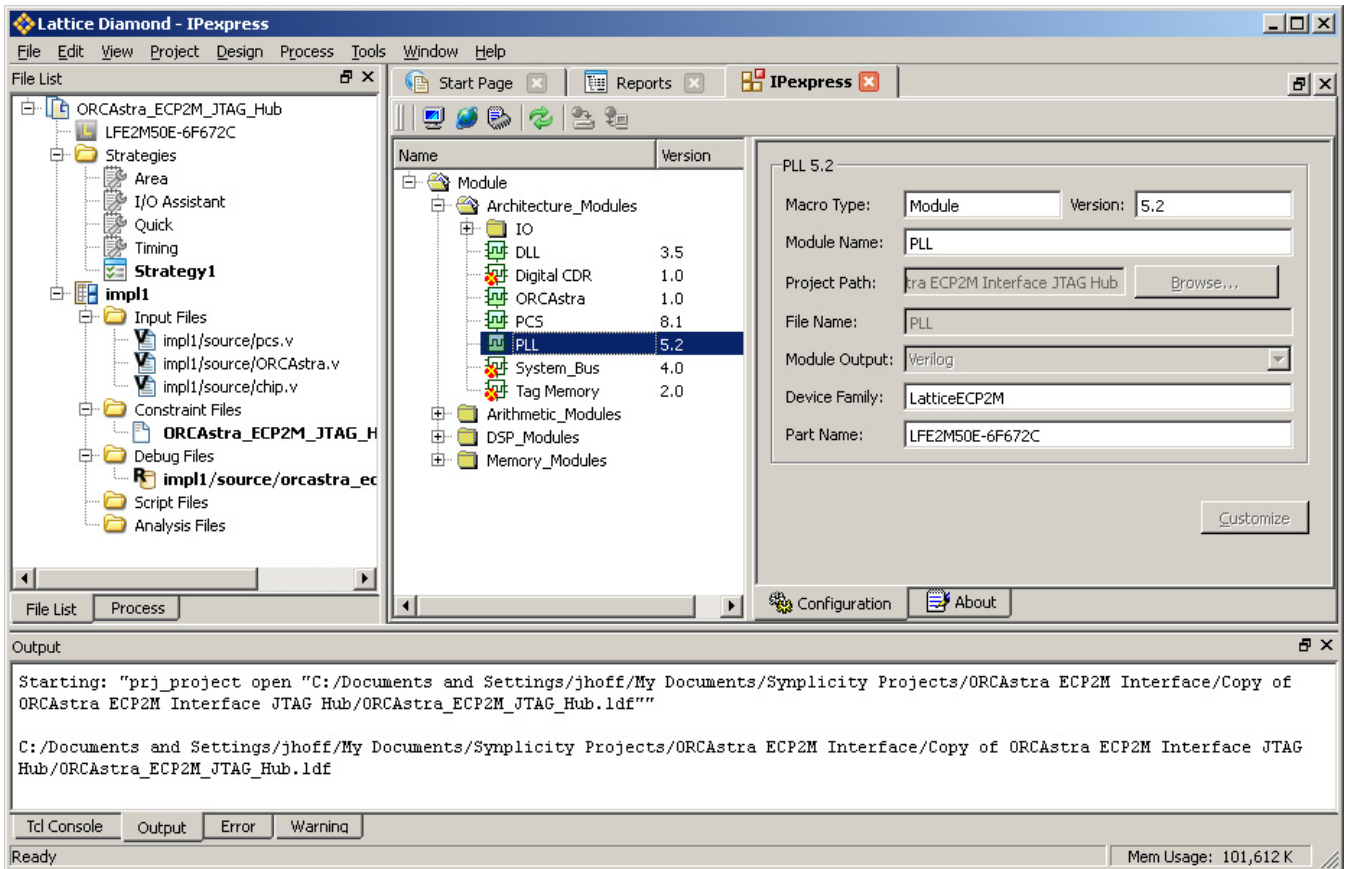
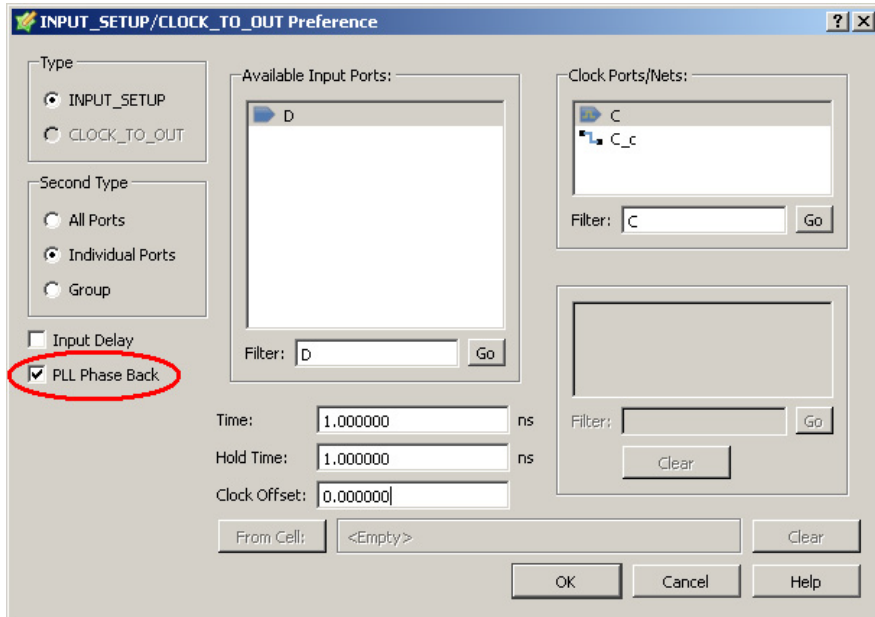


Figure 10-41. Diamond INPUT_SETUP Preference Window (see Figure 10-37 for ispLEVER Equivalent)



Introduction

This technical note discusses memory usage for the LatticeECP2™ and LatticeECP2M™ device families. It is intended to be used by design engineers as a guide for integrating the EBR- (Embedded Block RAM) and PFU-based memories in this device family using the ispLEVER® design tool.

The architecture of these devices provides resources for FPGA on-chip memory applications. The sysMEM™ EBR complements the distributed PFU-based memory. Single-Port RAM, Dual-Port RAM, Pseudo Dual-Port RAM, FIFO and ROM memories can be constructed using the EBR. LUTs and PFU can implement Distributed Single-Port RAM, Dual-Port RAM and ROM.

The capabilities of the EBR RAM and PFU RAM are referred to as primitives and are described later in this document. Designers can utilize the memory primitives in two ways via the IPexpress™ tool in the ispLEVER software. The IPexpress GUI allows users to specify the memory type and size required. IPexpress takes this specification and constructs a netlist to implement the desired memory by using one or more of the memory primitives.

The remainder of this document discusses the use of IPexpress, memory modules and memory primitives.

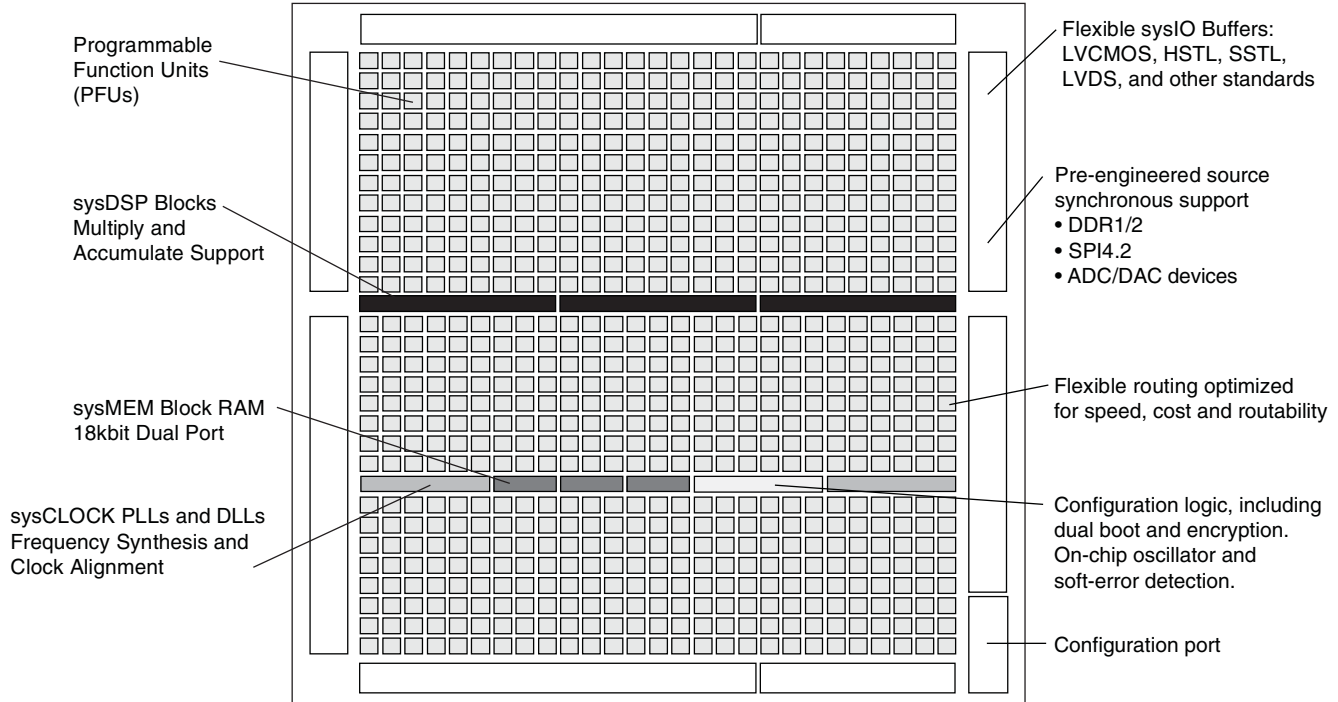
Memories in LatticeECP2/M Devices

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM, ROM and register functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2 family of devices contains up to two rows of sysMEM EBR blocks and the LatticeECP2M family of devices contains up to seven rows of sysMEM EBR blocks. sysMEM EBRs are large, dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of sysDSP™ blocks. Each sysDSP block has multipliers and accumulators, which are the building blocks for complex signal processing capabilities

Table 11-1. LatticeECP2/M LUT and Memory Densities

| LUTs | 6K | 12K | 20K | | 35K | | 50K | | 70K | | 100K |
|-------------------------|--------|---------|---------|----------|---------|----------|---------|----------|---------|----------|-----------|
| Device | ECP2-6 | ECP2-12 | ECP2-20 | ECP2M-20 | ECP2-35 | ECP2M-35 | ECP2-50 | ECP2M-50 | ECP2-70 | ECP2M-70 | ECP2M-100 |
| LUTs (K) | 6 | 12 | 21 | 19 | 32 | 34 | 48 | 48 | 68 | 67 | 95 |
| Distributed RAM (Kbits) | 12 | 24 | 42 | 41 | 65 | 71 | 96 | 101 | 136 | 145 | 202 |
| EBR SRAM Blocks | 3 | 12 | 15 | 66 | 18 | 114 | 21 | 225 | 60 | 246 | 288 |
| EBR SRAM (Kbits) | 55 | 221 | 276 | 1217 | 332 | 2101 | 387 | 4147 | 1106 | 4534 | 5308 |

Figure 11-1. Simplified Block Diagram, LatticeECP2-6 Device (Top Level)

Utilizing IPexpress

Designers can utilize IPexpress to easily specify a variety of memories in their designs. These modules are constructed using one or more memory primitives along with general purpose routing and LUTs, as required. The available primitives are:

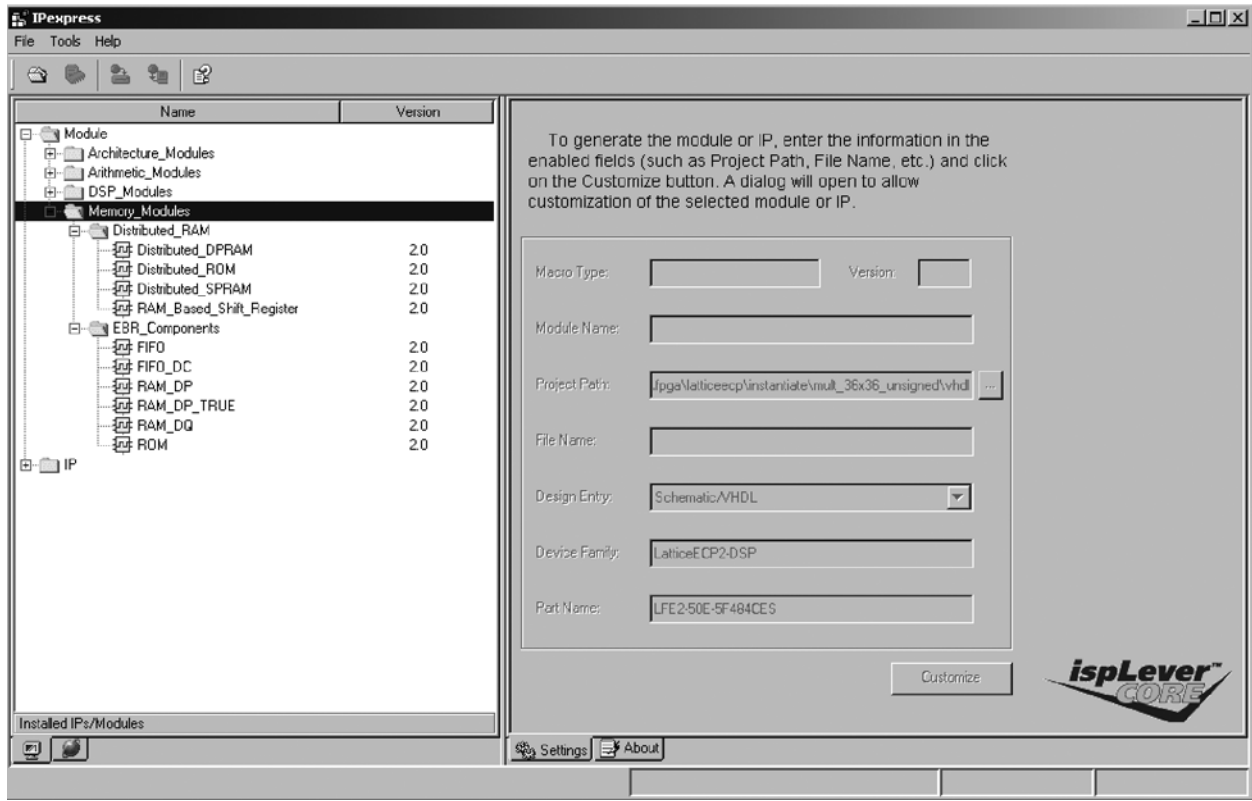
- Single Port RAM (RAM_DQ) – EBR-based
- Dual PORT RAM (RAM_DP_TRUE) – EBR-based
- Pseudo Dual Port RAM (RAM_DP) – EBR-based
- Read Only Memory (ROM) – EBR-Based
- First In First Out Memory (Dual Clock) (FIFO_DC) – EBR-based
- Distributed Single Port RAM (Distributed_SPRAM) – PFU-based
- Distributed Dual Port RAM (Distributed_DPRAM) – PFU-based
- Distributed ROM (Distributed_ROM) – PFU/PFF-based
- Distributed Shift Register (RAM_Based_Shift_Register) – PFU-based (see IPexpress Help for details)

IPexpress Flow

For generating any of these memories, create (or open) a project for the LatticeECP2/M devices.

From the Project Navigator, select **Tools > IPexpress** or click on the button in the toolbar when LatticeECP2/M devices are targeted in the project. This opens the IPexpress main window as shown in Figure 11-2.

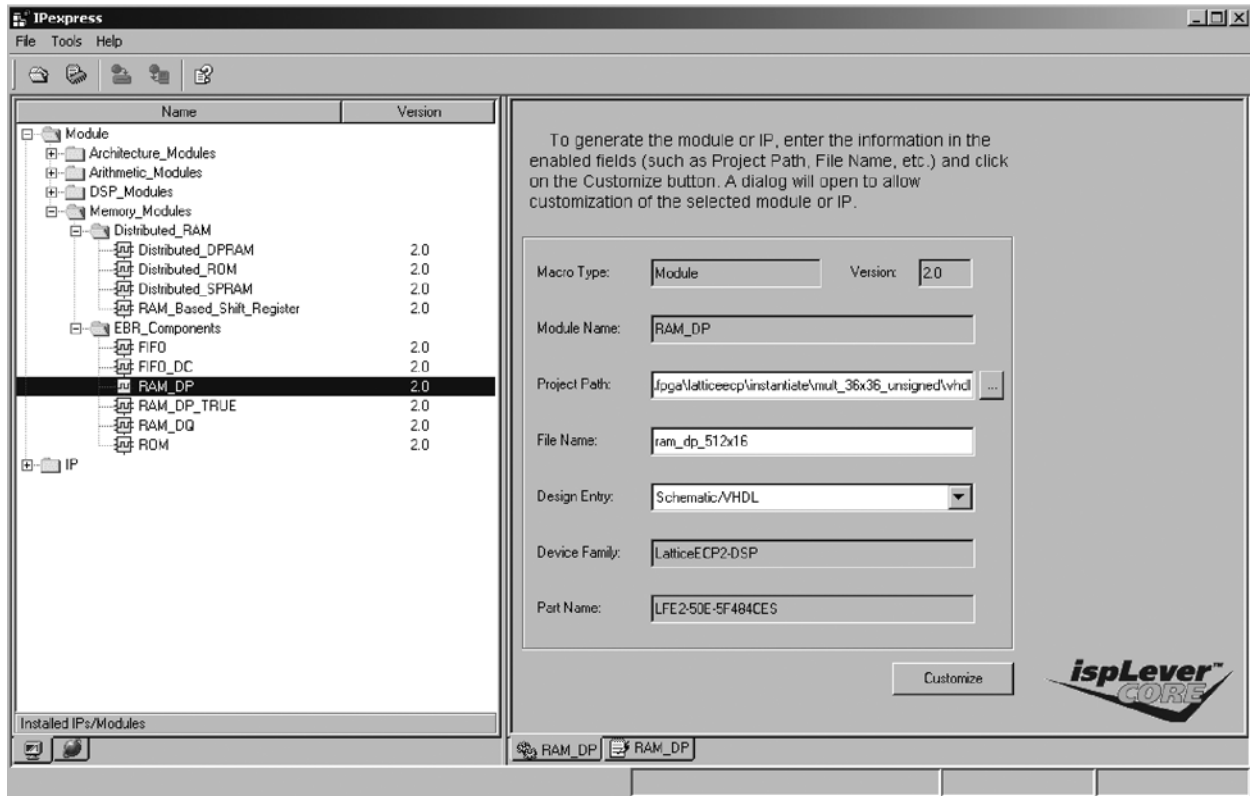
Figure 11-2. IPexpress – Main Window



The left pane of this window includes the Module Tree. The EBR-based Memory Modules are under the **EBR_Components** and the PFU-based Distributed Memory Modules are under **Storage_Components**, as shown in Figure 11-2.

As an example, let us consider generating an EBR-based Pseudo Dual Port RAM of size 512x16. Select **RAM_DP** under **EBR_Components**. The right pane changes as shown in Figure 11-3.

Figure 11-3. Example Generating Pseudo Dual Port RAM (RAM_DP) Using IPexpress



In the right pane, options like the **Device Family**, **Macro Type**, **Category**, and **Module Name** are device and selected module dependent. These cannot be changed in IPexpress.

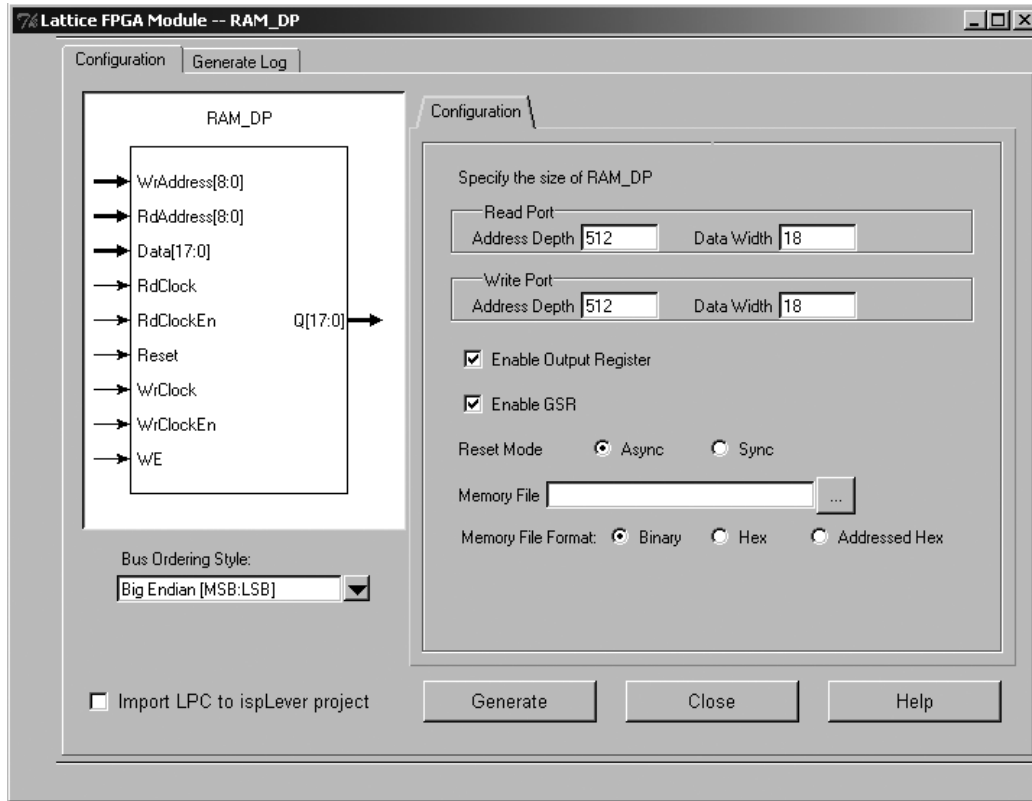
Users can change the directory where the generated module files will be placed by clicking the **Browse** button in the **Project Path**.

The **Module Name** text box allows users to specify an entity name for the module they are about to generate. Users must provide this entity name.

Design entry, Verilog or VHDL, by default, is the same as the project type. If the project is a VHDL project, the selected design entry option will be "Schematic/ VHDL", and "Schematic/ Verilog-HDL" if the project type is Verilog-HDL.

The **Device** pull-down menu allows users to select different devices within the same family, LatticeECP2/M in this example. By clicking the **Customize** button, another window opens where users can customize the RAM (Figure 11-4).

Figure 11-4. Example Generating Pseudo Dual Port RAM (RAM_DP) Module Customization



The left side of this window shows the block diagram of the module. The right side includes the **Configuration** tab where users can choose options to customize the RAM_DP (e.g. specify the address port sizes and data widths).

Users can specify the address depth and data width for the **Read Port** and the **Write Port** in the text boxes provided. In this example, we are generating a Pseudo Dual Port RAM of size 512 x 16. Users can also create RAMs of different port widths for Pseudo Dual Port and True Dual Port RAMs.

The Input Data and the Address Control are always registered, as the hardware only supports the clocked write operation for the EBR based RAMs. The check box **Enable Output Registers** inserts the output registers in the Read Data Port. Output registers are optional for EBR-based RAMs.

Users have the option to set the **Reset Mode** as Asynchronous Reset or Synchronous Reset. **Enable GSR** can be checked to enable the Global Set Reset. If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active. These instructions apply to all EBR RAM and ROM implementations. Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

Users can also pre-initialize their memory with the contents specified in the **Memory File**. It is optional to provide this file in the RAM; however for ROM, the Memory File is required. These files can be of Binary, Hex or Addresses Hex format. The details of these formats are discussed in the Initialization File section of this document.

At this point, users can click the **Generate** button to generate the module they have customized. A VHDL or Verilog netlist is then generated and placed in the specified location. Users can incorporate this netlist in their designs.

Another important button is the **Load Parameters** button. IPexpress stores the parameters specified in a <module_name>.lpc file. This file is generated along with the module. Users can click on the Load Parameters button to load the parameters of a previously generated module to re-visit or make changes to them.

Once the module is generated, users can either instantiate the *.lpc or the Verilog-HDL/ VHDL file in top-level module of their design.

The various memory modules, both EBR and distributed, are discussed in detail in this document.

Memory Modules

ECC is supported in most memories. If you choose to use ECC, you will have a 2-bit error signal.

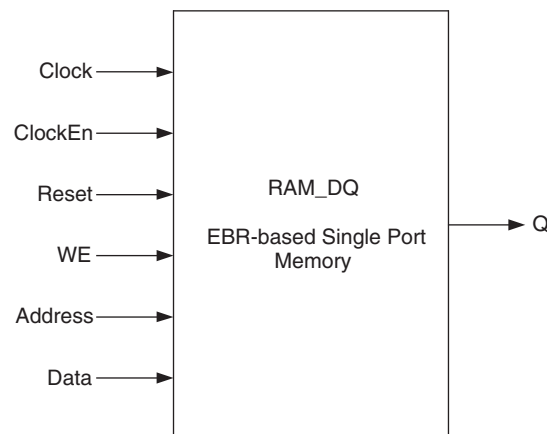
- When Error[1:0]=00, there is no error.
- When Error[0]=1, it indicates that there was a 1 bit error which was fixed.
- When Error[1]=1, it indicates that there was a 2-bit error which cannot be corrected.

Single Port RAM (RAM_DQ) – EBR Based

The EBR blocks in LatticeECP2/M devices can be configured as Single Port RAM or RAM_DQ. IPexpress allows users to generate the Verilog-HDL or VHDL along EDIF netlist for the memory size as per design requirements.

IPexpress generates the memory module as shown in Figure 11-5.

Figure 11-5. Single Port Memory Module Generated by IPexpress



Since the device has a number of EBR blocks, the generated module makes use of these EBR blocks, or primitives, and cascades them to create the memory sizes specified by the user in the IPexpress GUI. For memory sizes smaller than an EBR block, the module will be created in one EBR block. For memory sizes larger than one EBR block, multiple EBR blocks can be cascaded in depth or width (as required to create these sizes).

In Single Port RAM mode, the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

The various ports and their definitions for the Single Port Memory are listed in Table 11-2. The table lists the corresponding ports for the module generated by IPexpress and for the EBR RAM_DQ primitive.

Table 11-2. EBR-based Single Port Memory Port Definitions

| Port Name in Generated Module | Port Name in the EBR Block Primitive | Description | Active State |
|-------------------------------|--------------------------------------|--------------|-------------------|
| Clock | CLK | Clock | Rising Clock Edge |
| ClockEn | CE | Clock Enable | Active High |
| Address | AD[x:0] | Address Bus | — |
| Data | DI[y:0] | Data In | — |
| Q | DO[y:0] | Data Out | — |
| WE | WE | Write Enable | Active High |
| Reset | RST | Reset | Active High |
| — | CS[2:0] | Chip Select | — |

Reset (or RST) resets only the input and output registers of the RAM. It does not reset the contents of the memory.

Chip Select (CS) is a useful port in the EBR primitive when multiple cascaded EBR blocks are required by the memory. The CS signal forms the MSB for the address when multiple EBR blocks are cascaded. CS is a 3-bit bus, so it can cascade eight memories easily. If the memory size specified by the user requires more than eight EBR blocks, the ispLEVER software automatically generates the additional address decoding logic, which is implemented in the PFU (external to the EBR blocks).

Each EBR block consists of 18,432 bits of RAM. The values for x (address) and y (data) for each EBR block for the devices are listed in Table 11-3.

Table 11-3. Single Port Memory Sizes for 16K Memories for LatticeECP2/M

| Single Port Memory Size | Input Data | Output Data | Address [MSB:LSB] |
|-------------------------|------------|-------------|-------------------|
| 16K x 1 | DI | DO | AD[13:0] |
| 8K x 2 | DI[1:0] | DO[1:0] | AD[12:0] |
| 4K x 4 | DI[3:0] | DO[3:0] | AD[11:0] |
| 2K x 9 | DI[8:0] | DO[8:0] | AD[10:0] |
| 1K x 18 | DI[17:0] | DO[17:0] | AD[9:0] |
| 512 x 36 | DI[35:0] | DO[35:0] | AD[8:0] |

Table 11-4 shows the various attributes available for the Single Port Memory (RAM_DQ). Some of these attributes are user-selectable through the IPexpress GUI. For detailed attribute definitions, refer to Appendix A.

Table 11-4. Single Port RAM Attributes for LatticeECP2/M

| Attribute | Description | Values | Default Value | User Selectable Through IPexpress |
|-------------------------|---|---|--|-----------------------------------|
| Address depth | Address Depth Read Port | 16K, 8K, 4K, 2K, 1K, 512 | | YES |
| Data Width | Data Word Width Read Port | 1, 2, 4, 9, 18, 36 | 1 | YES |
| Enable Output Registers | Register Mode (Pipelining) for Write Port | NOREG, OUTREG | NOREG | YES |
| Enable GSR | Enables Global Set Reset | ENABLE, DISABLE | ENABLE | YES |
| Reset Mode | Selects the Reset type | ASYNC, SYNC | ASYNC | YES |
| Memory File Format | | BINARY, HEX, ADDRESSED HEX | | YES |
| Write Mode | Read / Write Mode for Write Port | NORMAL, WRITE-THROUGH | NORMAL | YES |
| Chip Select Decode | Chip Select Decode for Read Port | 0b000, 0b001, 0b010, 0b011, 0b100, 0b101, 0b110, 0b111 | 0b000 | NO |
| Init Value | Initialization value | 0x00000000000000000000000000000000 00000000000000000000000000000000 00000000000000000000000000000000 000000000000.....0xFFFF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFF | 0x000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 00000 | NO |

The Single Port RAM (RAM_DQ) can be configured as NORMAL or WRITE THROUGH modes. Each of these modes affects the data coming out of port Q of the memory during the write operation followed by the read operation at the same memory location.

Additionally, users can select to enable the output registers for RAM_DQ. Figures 11-6-11-9 show the internal timing waveforms for the Single Port RAM (RAM_DQ) with these options.

It is important that no setup and hold time violations occur on the address registers (Address). Failing to meet these requirements can result in corruption of memory contents. This applies to both read and write operations.

A Post Place and Route timing report in Lattice Diamond® or ispLEVER design software can be run to verify that no such timing errors occur. Refer to the timing preferences in the Online Help documents.

Figure 11-6. Single Port RAM Timing Waveform – NORMAL Mode, without Output Registers

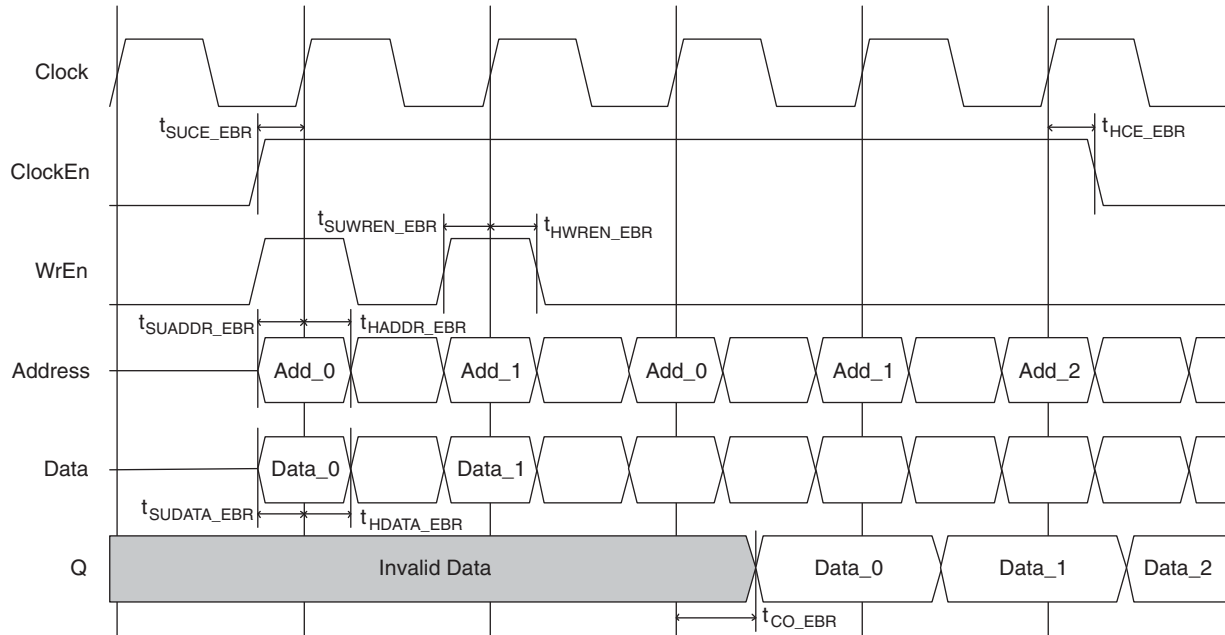


Figure 11-7. Single Port RAM Timing Waveform – NORMAL Mode, with Output Registers

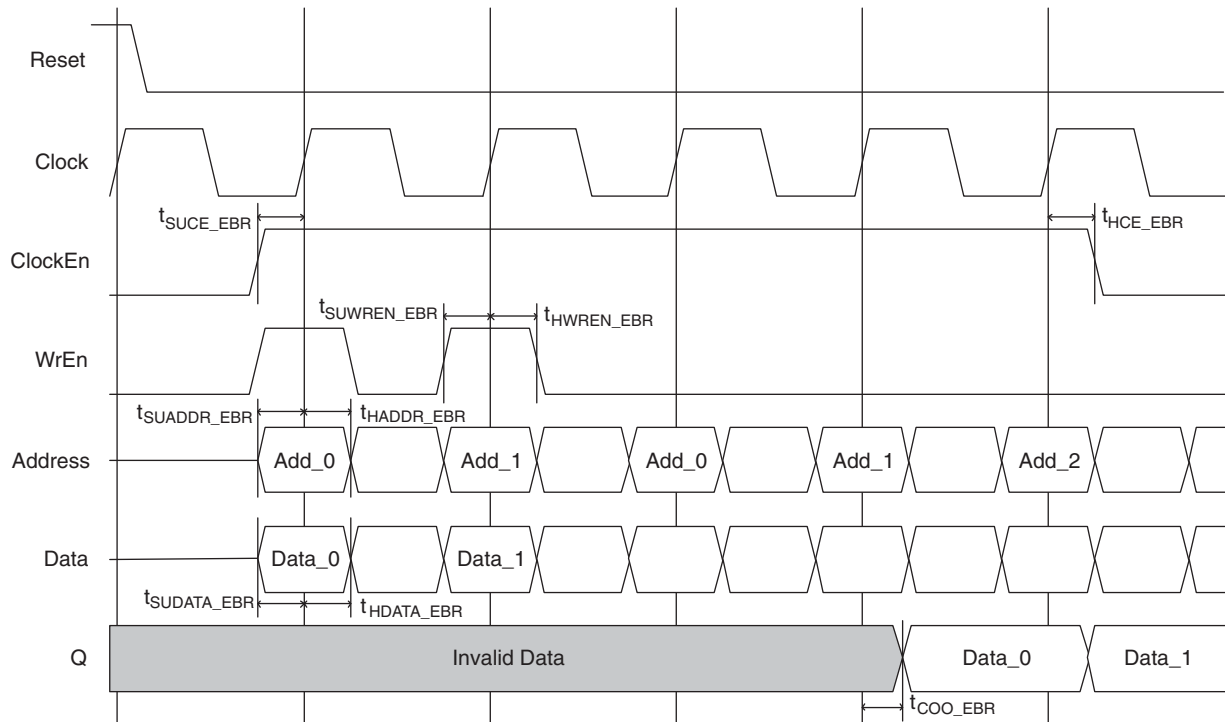


Figure 11-8. Single Port RAM Timing Waveform – WRITE THROUGH Mode, without Output Registers

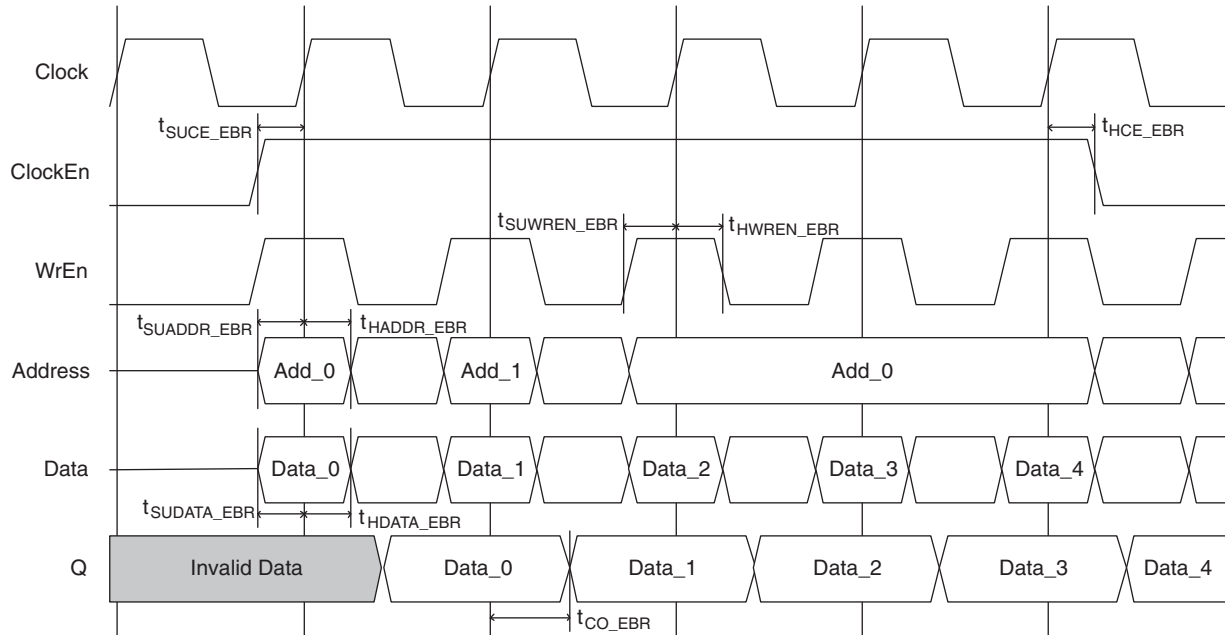
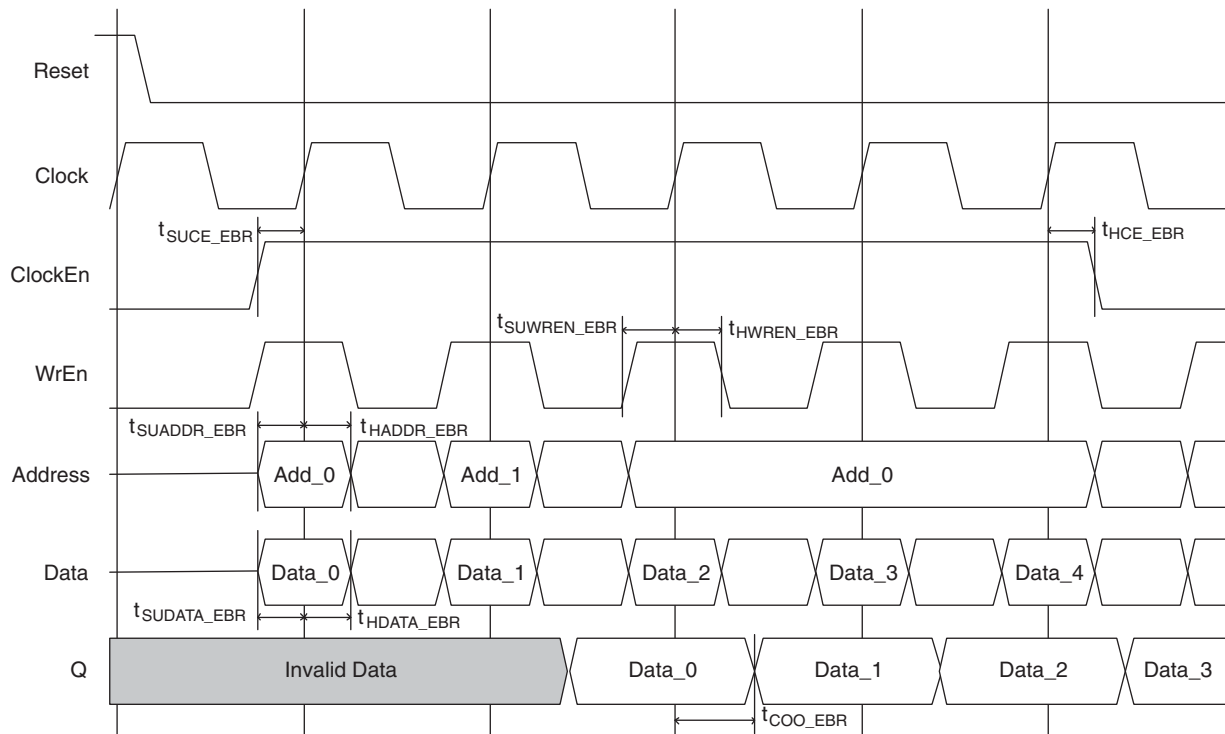


Figure 11-9. Single Port RAM Timing Waveform – WRITE THROUGH Mode, with Output Registers

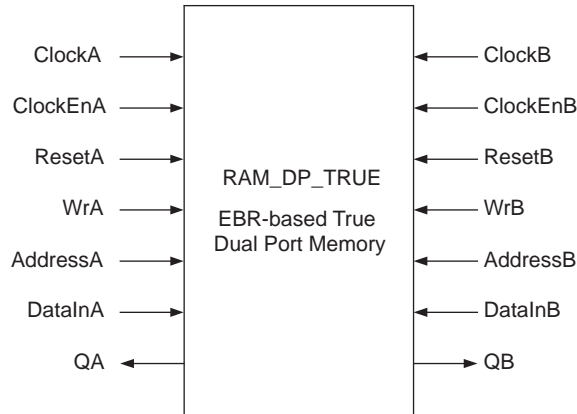


True Dual Port RAM (RAM_DP_TRUE) – EBR Based

The EBR blocks in the LatticeECP2/M devices can be configured as True-Dual Port RAM or RAM_DP_TRUE. IPexpress allows users to generate the Verilog-HDL, VHDL or EDIF netlists for the memory size as per design requirements.

IPexpress generates the memory module as shown in Figure 11-10.

Figure 11-10. True Dual Port Memory Module Generated by IPexpress



The generated module makes use of these EBR blocks or primitives. For memory sizes smaller than an EBR block, the module will be created in one EBR block. When the specified memory is larger than one EBR block, multiple EBR blocks can be cascaded in depth or width (as required to create these sizes).

In True Dual Port RAM mode, the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

The various ports and their definitions for Single Port Memory are listed in Table 11-5. The table lists the corresponding ports for the module generated by IPexpress and for the EBR RAM_DP_TRUE primitive.

Table 11-5. EBR-based True Dual Port Memory Port Definitions

| Port Name in Generated Module | Port Name in the EBR Block Primitive | Description | Active State |
|-------------------------------|--------------------------------------|--------------------------------------|-------------------|
| ClockA, ClockB | CLKA, CLKB | Clock for PortA and PortB | Rising Clock Edge |
| ClockEnA, ClockEnB | CEA, CEB | Clock Enables for Port CLKA and CLKB | Active High |
| AddressA, AddressB | ADA[18:19-x1], ADB[18:19-x2] | Address Bus port A and port B | — |
| DataA, DataB | DIA[y1:0], DIB[y2:0] | Input Data port A and port B | — |
| QA, QB | DOA[y1:0], DOB[y2:0] | Output Data port A and port B | — |
| WrA, WrB | WEA, WEB | Write enable port A and port B | Active High |
| ResetA, ResetB | RSTA, RSTB | Reset for PortA and PortB | Active High |
| — | CSA[2:0], CSB[2:0] | Chip Selects for each port | — |

Reset (or RST) resets only the input and output registers of the RAM. It does not reset the contents of the memory.

Chip Select (CS) is a useful port in the EBR primitive when multiple cascaded EBR blocks are required by the memory. The CS signal forms the MSB for the address when multiple EBR blocks are cascaded. Since CS is a 3-bit bus, it can cascade eight memories easily. However, if the memory size specified by the user requires more than eight EBR blocks, the ispLEVER software automatically generates the additional address decoding logic, which is implemented in the PFU external to the EBR blocks.

Each EBR block consists of 18,432 bits of RAM. The values for x's (for address) and y's (data) for each EBR block for the devices are listed in Table 11-6.

Table 11-6. True Dual Port Memory Sizes for 16K Memory for LatticeECP2/M

| Dual Port Memory Size | Input Data Port A | Input Data Port B | Output Data Port A | Output Data Port B | Address Port A [MSB:LSB] | Address Port B [MSB:LSB] |
|-----------------------|-------------------|-------------------|--------------------|--------------------|--------------------------|--------------------------|
| 16K x 1 | DIA | DIB | DOA | DOB | ADA[13:0] | ADB[13:0] |
| 8K x 2 | DIA[1:0] | DIB[1:0] | DOA[1:0] | DOB[1:0] | ADA[12:0] | ADB[12:0] |
| 4K x 4 | DIA[3:0] | DIB[3:0] | DOA[3:0] | DOB[3:0] | ADA[11:0] | ADB[11:0] |
| 2K x 9 | DIA[8:0] | DIB[8:0] | DOA[8:0] | DOB[8:0] | ADA[10:0] | ADB[10:0] |
| 1K x 18 | DIA[17:0] | DIB[17:0] | DOA[17:0] | DOB[17:0] | ADA[9:0] | ADB[9:0] |

Table 11-7 shows the various attributes available for the Single Port Memory (RAM_DQ). Some of these attributes are user-selectable through the IPexpress GUI. For detailed attribute definitions, refer to the Appendix A.

Table 11-7. True Dual Port RAM Attributes for LatticeECP2/M

| Attribute | Description | Values | Default Value | User Selectable Through IPexpress |
|--------------------------------|---------------------------------------|--|--|-----------------------------------|
| Port A Address depth | Address Depth Port A | 16K, 8K, 4K, 2K, 1K | | YES |
| Port A Data Width | Data Word Width Port A | 1, 2, 4, 9, 18 | 1 | YES |
| Port B Address depth | Address Depth Port B | 16K, 8K, 4K, 2K, 1K | | YES |
| Port B Data Width | Data Word Width Port B | 1, 2, 4, 9, 18 | 1 | YES |
| Port A Enable Output Registers | Register Mode (Pipelining) for Port A | NOREG, OUTREG | NOREG | YES |
| Port B Enable Output Registers | Register Mode (Pipelining) for Port B | NOREG, OUTREG | NOREG | YES |
| Enable GSR | Enables Global Set Reset | ENABLE, DISABLE | ENABLE | YES |
| Reset Mode | Selects the Reset type | ASYNC, SYNC | ASYNC | YES |
| Memory File Format | | BINARY, HEX, ADDRESSED HEX | | YES |
| Port A Write Mode | Read / Write Mode for Port A | NORMAL, WRITE-THROUGH | NORMAL | YES |
| Port B Write Mode | Read / Write Mode for Port B | NORMAL, WRITE-THROUGH | NORMAL | YES |
| Chip Select Decode for Port A | Chip Select Decode for Port A | 0b000, 0b001, 0b010, 0b011, 0b100, 0b101, 0b110, 0b111 | 0b000 | NO |
| Chip Select Decode for Port B | Chip Select Decode for Port B | 0b000, 0b001, 0b010, 0b011, 0b100, 0b101, 0b110, 0b111 | 0b000 | NO |
| Init Value | Initialization value | 0x00000000000000000000000000000000 00000000000000000000000000000000 00000000000000000000000000000000 0000000000000000.....0xF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFFFFFFFFFF | 0x00000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 0000000000 | NO |

Figure 11-13. True Dual Port RAM Timing Waveform – WRITE THROUGH Mode, without Output Registers

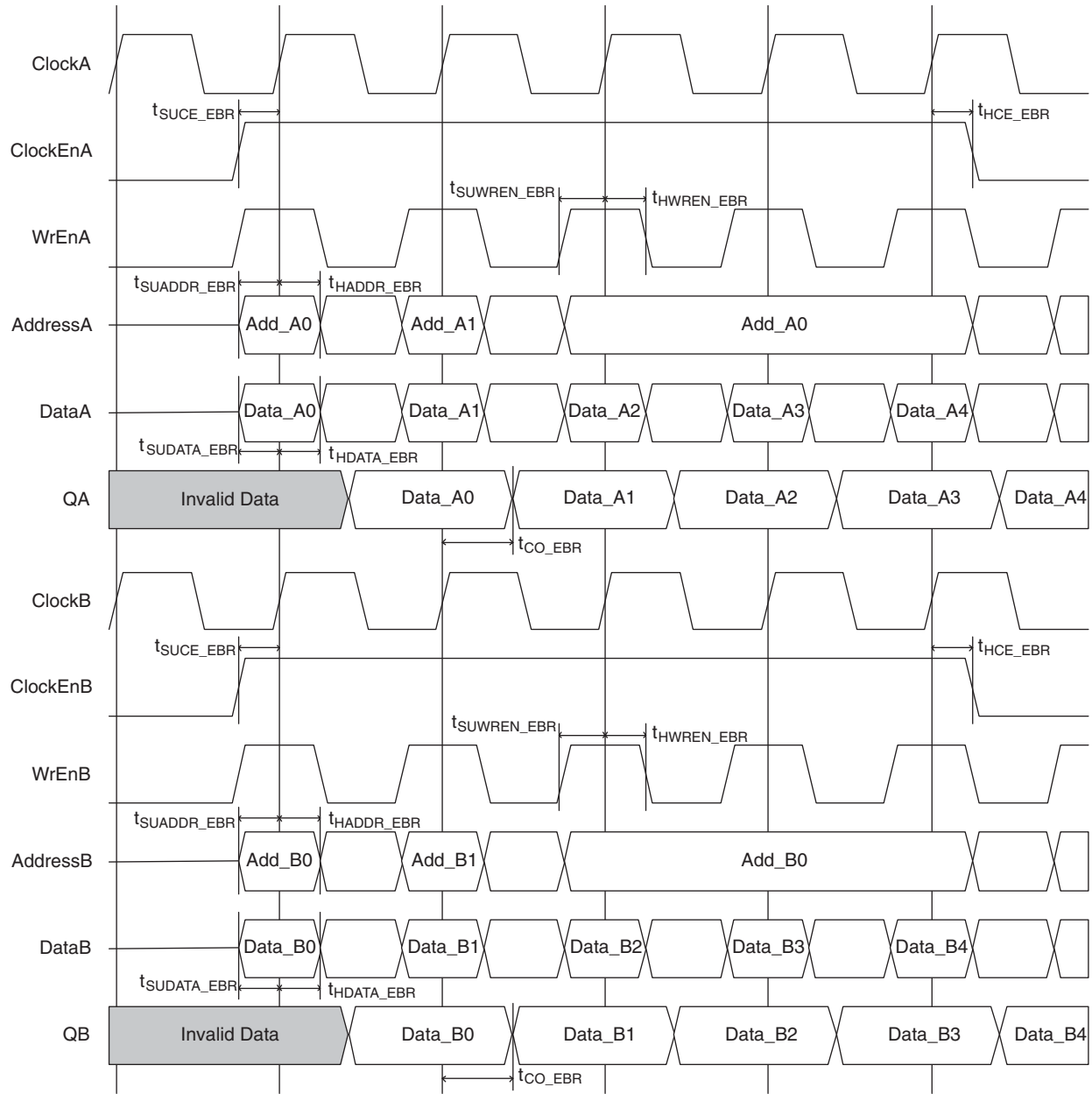
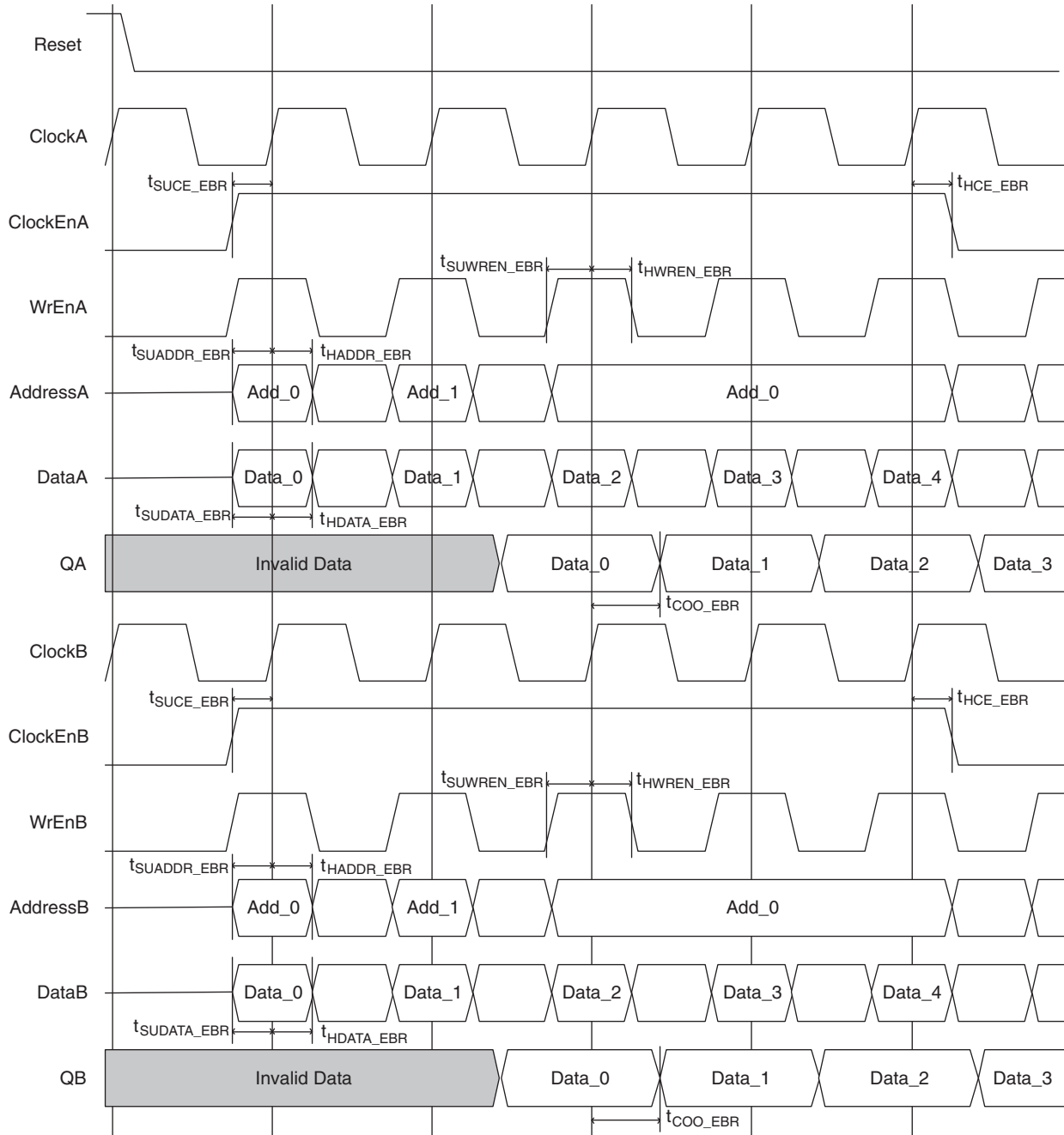


Figure 11-14. True Dual Port RAM Timing Waveform – WRITE THROUGH Mode, with Output Registers

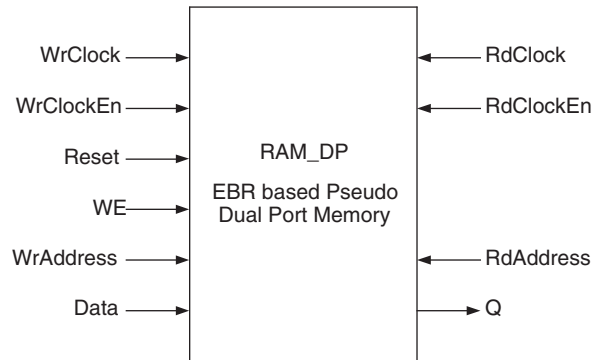


Pseudo Dual Port RAM (RAM_DP) – EBR Based

The EBR blocks in LatticeECP2/M devices can be configured as Pseudo-Dual Port RAM or RAM_DP. IPexpress allows users to generate the Verilog-HDL or VHDL along with EDIF netlists for the memory size as per design requirements.

IPexpress generates the memory module as shown in Figure 11-15.

Figure 11-15. Pseudo Dual Port Memory Module Generated by IPexpress



The generated module makes use of these EBR blocks or primitives. For memory sizes smaller than an EBR block, the module will be created in one EBR block. If the specified memory is larger than one EBR block, multiple EBR blocks can be cascaded in depth or width (as required to create these sizes).

In Pseudo Dual Port RAM mode, the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

The various ports and their definitions for the Single Port Memory are listed in Table 11-8. The table lists the corresponding ports for the module generated by IPexpress and for the EBR RAM_DP primitive.

Table 11-8. EBR-based Pseudo-Dual Port Memory Port Definitions

| Port Name in Generated Module | Port Name in the EBR Block Primitive | Description | Active State |
|-------------------------------|--------------------------------------|--------------------|-------------------|
| RdAddress | ADR[x1:0] | Read Address | — |
| WrAddress | ADW[x2:0] | Write Address | — |
| RdClock | CLKR | Read Clock | Rising Clock Edge |
| WrClock | CLKW | Write Clock | Rising Clock Edge |
| RdClockEn | CER | Read Clock Enable | Active High |
| WrClockEn | CEW | Write Clock Enable | Active High |
| Q | DO[y1:0] | Read Data | — |
| Data | DI[y2:0] | Write Data | — |
| WE | WE | Write Enable | Active High |
| Reset | RST | Reset | Active High |
| — | CS[2:0] | Chip Select | — |

Reset (RST) resets only the input and output registers of the RAM. It does not reset the contents of the memory.

Chip Select (CS) is a useful port when multiple cascaded EBR blocks are required by the memory. The CS signal forms the MSB for the address when multiple EBR blocks are cascaded. Since CS is a 3-bit bus, it can cascade eight memories easily. However, if the memory size specified by the user requires more than eight EBR blocks, the ispLEVER software automatically generates the additional address decoding logic, which is implemented in the PFU external to the EBR blocks.

Each EBR block consists of 18,432 bits of RAM. The values for x's (for address) and y's (data) for each EBR block for the devices are as in Table 11-9.

Table 11-9. Pseudo-Dual Port Memory Sizes for 16K Memory for LatticeECP2/M

| Pseudo-Dual Port Memory Size | Input Data Port A | Input Data Port B | Output Data Port A | Output Data Port B | Read Address Port A [MSB:LSB] | Write Address Port B [MSB:LSB] |
|------------------------------|-------------------|-------------------|--------------------|--------------------|-------------------------------|--------------------------------|
| 16K x 1 | DIA | DIB | DOA | DOB | RAD[13:0] | WAD[13:0] |
| 8K x 2 | DIA[1:0] | DIB[1:0] | DOA[1:0] | DOB[1:0] | RAD[12:0] | WAD[12:0] |
| 4K x 4 | DIA[3:0] | DIB[3:0] | DOA[3:0] | DOB[3:0] | RAD[11:0] | WAD[11:0] |
| 2K x 9 | DIA[8:0] | DIB[8:0] | DOA[8:0] | DOB[8:0] | RAD[10:0] | WAD[10:0] |
| 1K x 18 | DIA[17:0] | DIB[17:0] | DOA[17:0] | DOB[17:0] | RAD[9:0] | WAD[9:0] |
| 512 x 36 | DIA[35:0] | DIB[35:0] | DOA[35:0] | DOB[35:0] | RAD[8:0] | WAD[8:0] |

Table 11-10 shows the various attributes available for the Pseudo-Dual Port Memory (RAM_DP). Some of these attributes are user-selectable through the IPexpress GUI. For detailed attribute definitions, refer to Appendix A.

Table 11-10. Pseudo-Dual Port RAM Attributes for LatticeECP2/M

| Attribute | Description | Values | Default Value | User Selectable Through IPexpress |
|------------------------------------|---|--|--|-----------------------------------|
| Read Port Address Depth | Address Depth Read Port | 16K, 8K, 4K, 2K, 1K, 512 | | YES |
| Read Port Data Width | Data Word Width Read Port | 1, 2, 4, 9, 18, 36 | 1 | YES |
| Write Port Address Depth | Address Depth Write Port | 16K, 8K, 4K, 2K, 1K | | YES |
| Write Port Data Width | Data Word Width Write Port | 1, 2, 4, 9, 18, 36 | 1 | YES |
| Write Port Enable Output Registers | Register Mode (Pipelining) for Write Port | NOREG, OUTREG | NOREG | YES |
| Enable GSR | Enables Global Set Reset | ENABLE, DISABLE | ENABLE | YES |
| Reset Mode | Selects the Reset type | ASYNCR, SYNC | ASYNCR | YES |
| Memory File Format | | BINARY, HEX, ADDRESSED HEX | | YES |
| Read Port Write Mode | Read / Write Mode for Read Port | NORMAL | NORMAL | YES |
| Write Port Write Mode | Read / Write Mode for Write Port | NORMAL | NORMAL | YES |
| Chip Select Decode for Read Port | Chip Select Decode for Read Port | 0b000, 0b001, 0b010, 0b011, 0b100, 0b101, 0b110, 0b111 | 0b000 | NO |
| Chip Select Decode for Write Port | Chip Select Decode for Write Port | 0b000, 0b001, 0b010, 0b011, 0b100, 0b101, 0b110, 0b111 | 0b000 | NO |
| Init Value | Initialization value | 0x00000000000000000000000000000000 00000000000000000000000000000000 00000000000000000000000000000000 0.....0xFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFFFFFFFFFF FFFFFFFFFFFFFFFF FFFFFFFF | 0x000000000000 000000000000 000000000000 000000000000 000000000000 000000000000 000000000000 000000000000 | NO |

Users have the option to enable the output registers for Pseudo-Dual Port RAM (RAM_DP). Figures 11-16 and 11-17 show the internal timing waveforms for Pseudo-Dual Port RAM (RAM_DP) with these options. It is important that no setup and hold time violations occur on the address registers (RdAddress and WrAddress). Failing to meet these requirements can result in corruption of memory contents. This applies to both read and write operations.

A Post Place and Route timing report in Lattice Diamond or ispLEVER design software can be run to verify that no such timing errors occur. Refer to the timing preferences in the Online Help documents.

Figure 11-16. PSEUDO DUAL PORT RAM Timing Diagram – without Output Registers

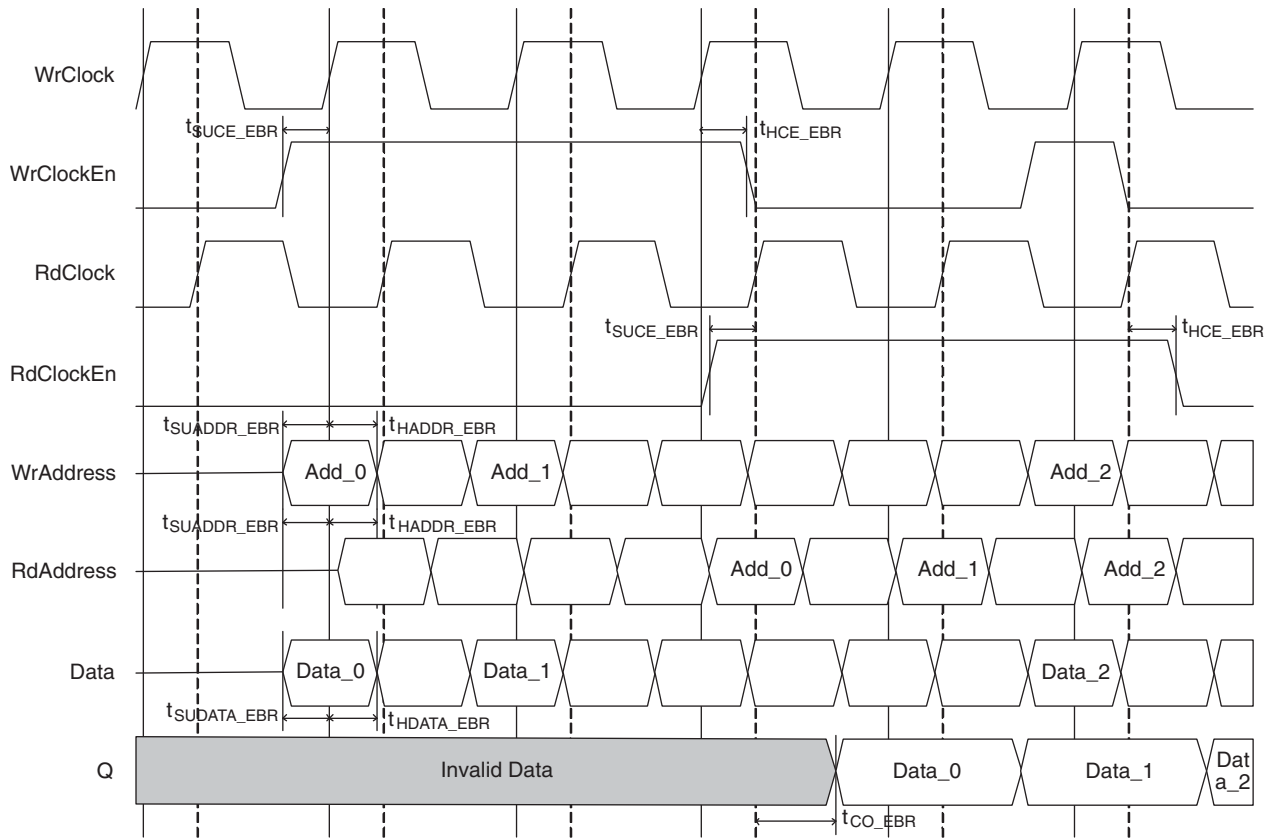
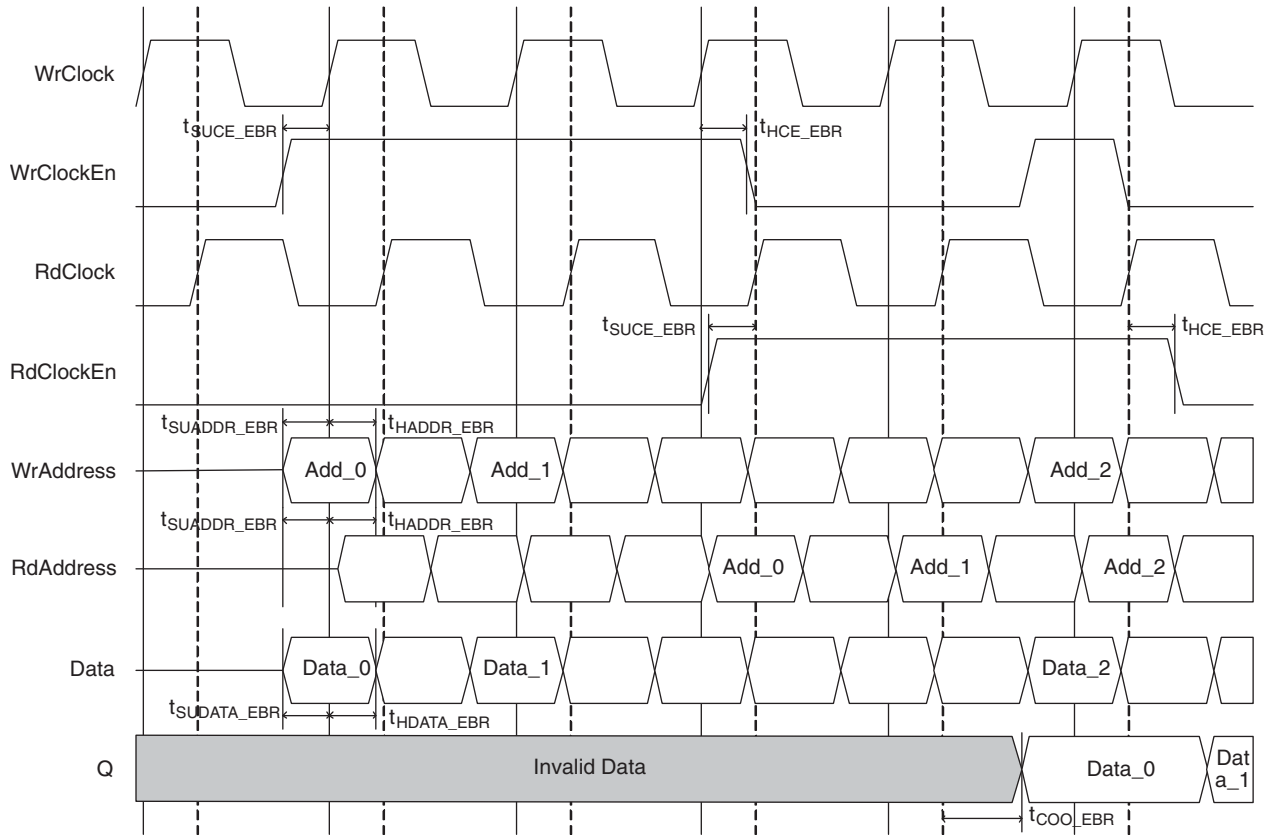


Figure 11-17. PSEUDO DUAL PORT RAM Timing Diagram – with Output Registers

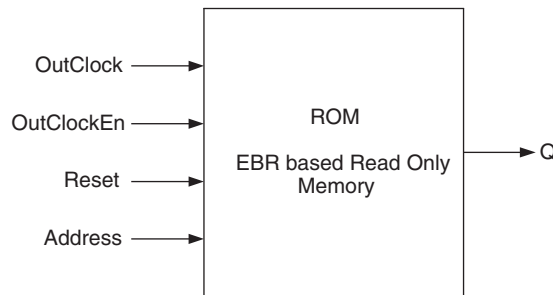


Read Only Memory (ROM) – EBR Based

The EBR blocks in the LatticeECP2/M devices can be configured as Read Only Memory or ROM. IPexpress allows users to generate the Verilog-HDL or VHDL and the EDIF netlist for the memory size, as per design requirements. Users are required to provide the ROM memory content in the form of an initialization file.

IPexpress generates the memory module as shown in Figure 11-18.

Figure 11-18. Read-Only Memory Module Generated by IPexpress



The generated module makes use of these EBR blocks or primitives. For memory sizes smaller than an EBR block, the module will be created in one EBR block. If the specified memory is larger than one EBR block, multiple EBR blocks can be cascaded, in depth or width (as required to create these sizes).

In ROM mode, the address for the port is registered at the input of the memory array. The output data of the memory is optionally registered at the output.

The various ports and their definitions for the ROM are listed in Table 11-11. The table lists the corresponding ports for the module generated by IPexpress and for the ROM primitive.

Table 11-11. EBR-based ROM Port Definitions

| Port Name in Generated Module | Port Name in the EBR block Primitive | Description | Active State |
|-------------------------------|--------------------------------------|--------------|-------------------|
| Address | AD[x:0] | Read Address | — |
| OutClock | CLK | Clock | Rising Clock Edge |
| OutClockEn | CE | Clock Enable | Active High |
| Reset | RST | Reset | Active High |
| — | CS[2:0] | Chip Select | — |

Reset (RST) resets only the input and output registers of the RAM. It does not reset the contents of the memory.

Chip Select (CS) is a useful port when multiple cascaded EBR blocks are required by the memory. The CS signal forms the MSB for the address when multiple EBR blocks are cascaded. Since CS is a 3-bit bus, it can cascade eight memories easily. However, if the memory size specified by the user requires more than eight EBR blocks, the ispLEVER software automatically generates the additional address decoding logic, which is implemented in the PFU external to the EBR blocks.

While generating the ROM using IPexpress, the user must provide the initialization file to pre-initialize the contents of the ROM. These files are the *.mem files and they can be of Binary, Hex or the Addressed Hex formats. The initialization files are discussed in detail in the Initializing Memory section of this document.

Users have the option of enabling the output registers for Read Only Memory (ROM). Figures 11-19 and 11-20 show the internal timing waveforms for the Read Only Memory (ROM) with these options.

Each EBR block consists of 18,432 bits of RAM. The values for x's (for address) and y's (data) for each EBR block for the devices are as per Table 11-12.

Table 11-12. ROM Memory Sizes for 16K Memory for LatticeECP2/M

| ROM | Output Data | Address Port [MSB:LSB] |
|----------|-------------|------------------------|
| 16K x 1 | DOA | WAD[13:0] |
| 8K x 2 | DOA[1:0] | WAD[12:0] |
| 4K x 4 | DOA[3:0] | WAD[11:0] |
| 2K x 9 | DOA[8:0] | WAD[10:0] |
| 1K x 18 | DOA[17:0] | WAD[9:0] |
| 512 x 36 | DOA[35:0] | WAD[8:0] |

Table 11-13 shows the various attributes available for the Read Only Memory (ROM). Some of these attributes are user-selectable through the IPexpress GUI. For detailed attribute definitions, refer to Appendix A.

Users have the option to enable the output registers for Read Only Memory (ROM). Figures 11-19 and 11-20 show the internal timing waveforms for ROM with these options.

It is important that no setup and hold time violations occur on the address registers (Address). Failing to meet these requirements can result in corruption of memory contents. This applies to both read operations in this case.

A Post Place and Route timing report in Lattice Diamond or ispLEVER design software can be run to verify that no such timing errors occur. Refer to the timing preferences in the Online Help documents.

Table 11-13. ROM Attributes for LatticeECP2/M

| Attribute | Description | Values | Default Value | User Selectable Through IPexpress |
|-------------------------|---|--|---------------|-----------------------------------|
| Address depth | Address Depth Read Port | 16K, 8K, 4K, 2K, 1K, 512 | | YES |
| Data Width | Data Word Width Read Port | 1, 2, 4, 9, 18, 36 | 1 | YES |
| Enable Output Registers | Register Mode (Pipelining) for Write Port | NOREG, OUTREG | NOREG | YES |
| Enable GSR | Enables Global Set Reset | ENABLE, DISABLE | ENABLE | YES |
| Reset Mode | Selects the Reset type | ASYNC, SYNC | ASYNC | YES |
| Memory File Format | | BINARY, HEX, ADDRESSED HEX | | YES |
| Chip Select Decode | Chip Select Decode for Read Port | 0b000, 0b001, 0b010, 0b011, 0b100, 0b101, 0b110, 0b111 | 0b000 | NO |

Figure 11-19. ROM Timing Waveform – without Output Registers

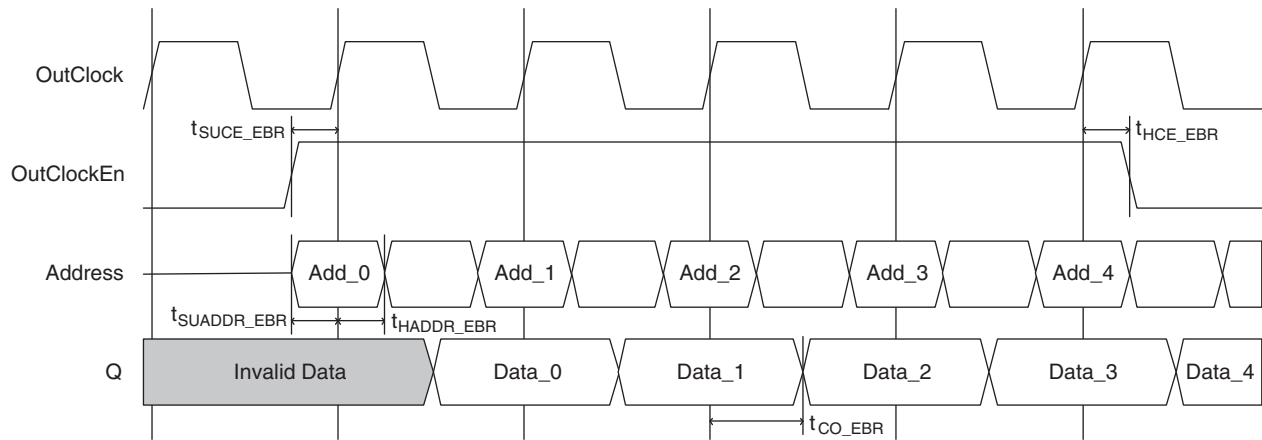
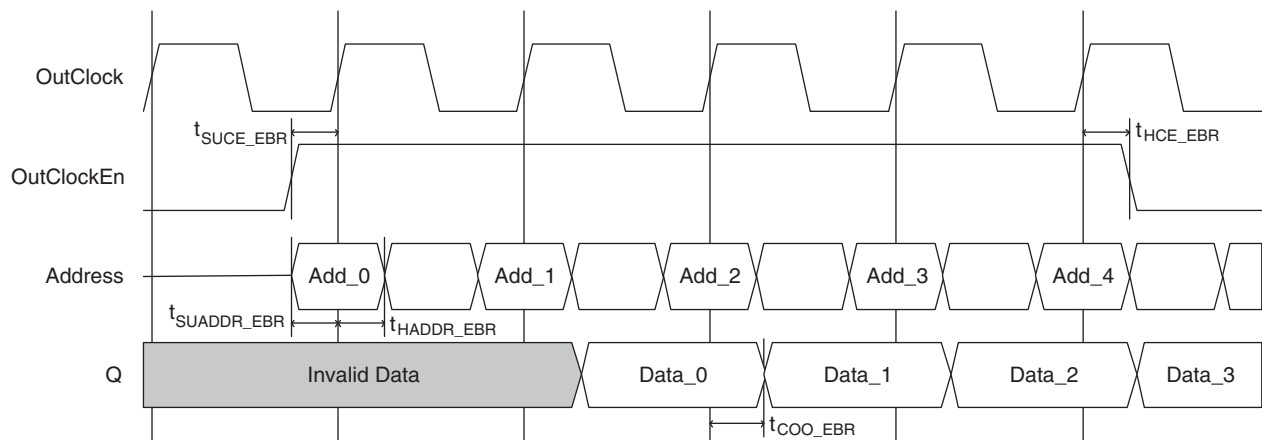


Figure 11-20. ROM Timing Waveform – with Output Registers



First In First Out (FIFO, FIFO_DC) – EBR Based

The hardware has Embedded Block RAM (EBR) which can be configured in Single Port (RAM_DQ), Pseudo-Dual Port (RAM_DP) and True Dual Port (RAM_DP_TRUE) RAMs. The FIFOs in these devices can be built using these RAMs. The IPexpress point tool in the ispLEVER design software allows users to build a FIFO and FIFO_DC around Pseudo Dual Port RAM (or DP_RAM).

Each of these FIFOs can be configured with (pipelined) and without (non-pipelined) output registers. In the pipelined mode users have an extra option to enable the output registers by the RdEn signal. We will discuss the operation in the following sections.

Let us take a look at the operation of these FIFOs.

First In First Out (FIFO) Memory

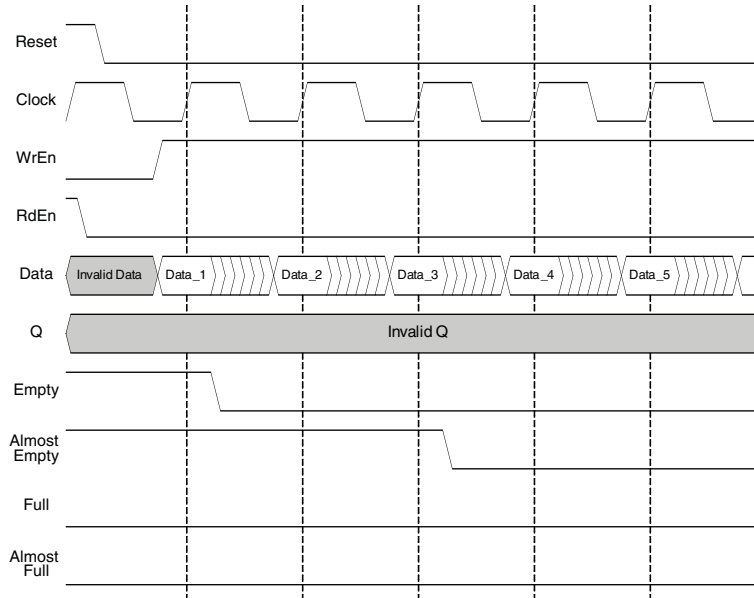
The FIFO, or the single clock FIFO, is an emulated FIFO. The address logic and the flag logic is implemented in the FPGA fabric around the RAM.

The ports available on the FIFO are:

- Reset
- Clock
- WrEn
- RdEn
- Data
- Q
- Full Flag
- Almost Full Flag
- Empty Flag
- Almost Empty Flag

Let us first discuss the non-pipelined or the FIFO without output registers. Figure 11-21 shows the operation of the FIFO when it is empty and the data starts to get written into it.

Figure 11-21. FIFO without Output Registers, Start of Data Write Cycle

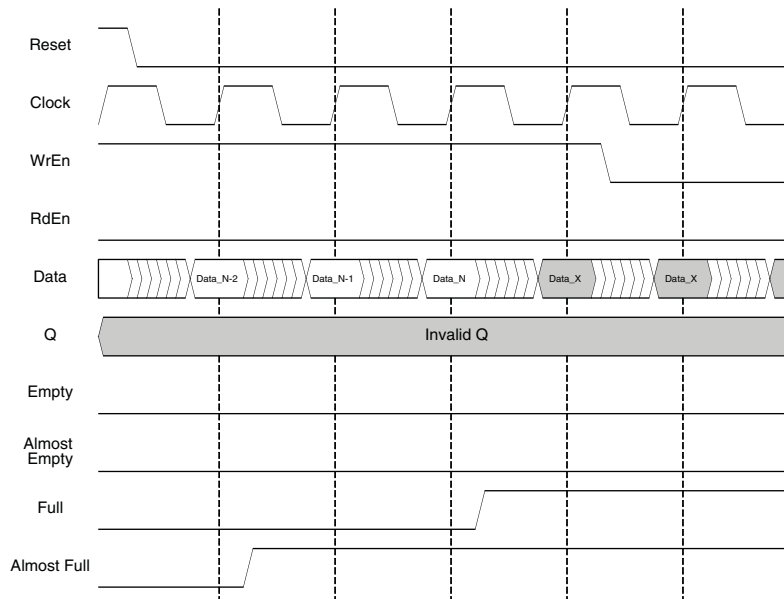


The WrEn signal must be high to start writing into the FIFO. The Empty and Almost Empty flags are high to begin and Full and Almost Full are low.

When the first data is written into the FIFO, the Empty flag de-asserts (or goes low), as the FIFO is no longer empty. In this figure we assume that the Almost Empty setting flag setting is 3 (address location 3). So the Almost Empty flag gets de-asserted when the third address location is filled.

Now let us assume that we continue to write into the FIFO to fill it. When the FIFO is filled, the Almost Full and Full Flags are asserted. Figure 11-22 shows the behavior of these flags. In this figure we assume that FIFO depth is 'N'.

Figure 11-22. FIFO without Output Registers, End of Data Write Cycle

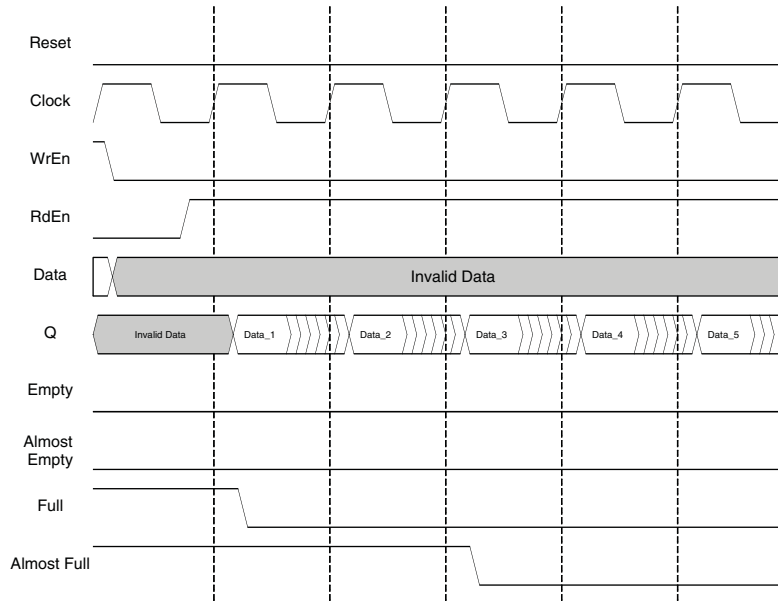


In this case, the Almost Full flag is in the 2 location before the FIFO is filled. The Almost Full flag is asserted when the N-2 location is written, and the Full flag is asserted when the last word is written into the FIFO.

Data_X data inputs do not get written as the FIFO is full (the Full flag is high).

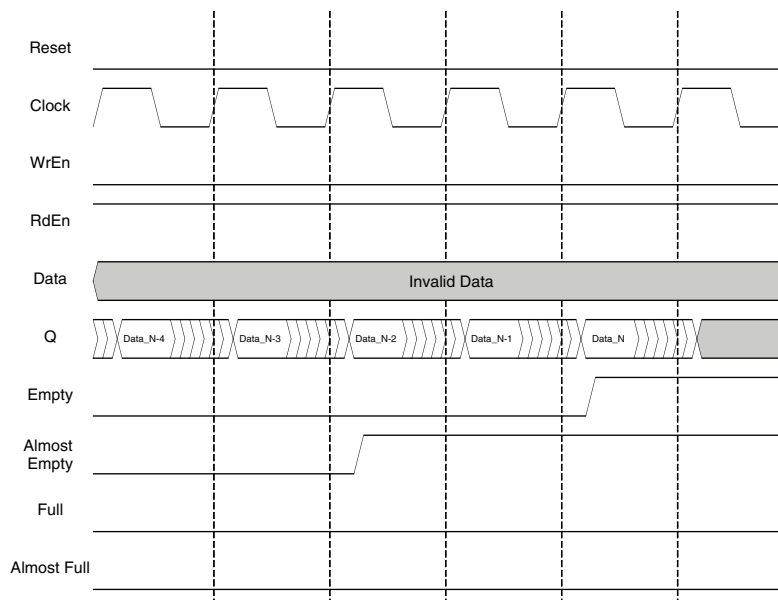
Now let us look at the waveforms when the contents of the FIFO are read out. Figure 11-23 shows the start of the read cycle. RdEn goes high and the data read starts. The Full and Almost Full flags are de-asserted, as shown.

Figure 11-23. FIFO without Output Registers, Start of Data Read Cycle



Similarly, as the data is read out and FIFO is emptied, the Almost Empty and Empty flags are asserted.

Figure 11-24. FIFO without Output Registers, End of Data Read Cycle



Figures 11-21 to 11-24 show the behavior of non-pipelined FIFO or FIFO without output registers. When we pipeline the registers, the output data is delayed by one clock cycle. There is also the extra option for Output registers to be enabled by the RdEn signal.

Figures 11-25 to 11-28 show the similar waveforms for the FIFO with output register and with output register enable with RdEn. It should be noted that flags are asserted and de-asserted with similar timing to the FIFO without output registers. However, it is only the data out 'Q' that is delayed by one clock cycle.

Figure 11-25. FIFO with Output Registers, Start of Data Write Cycle

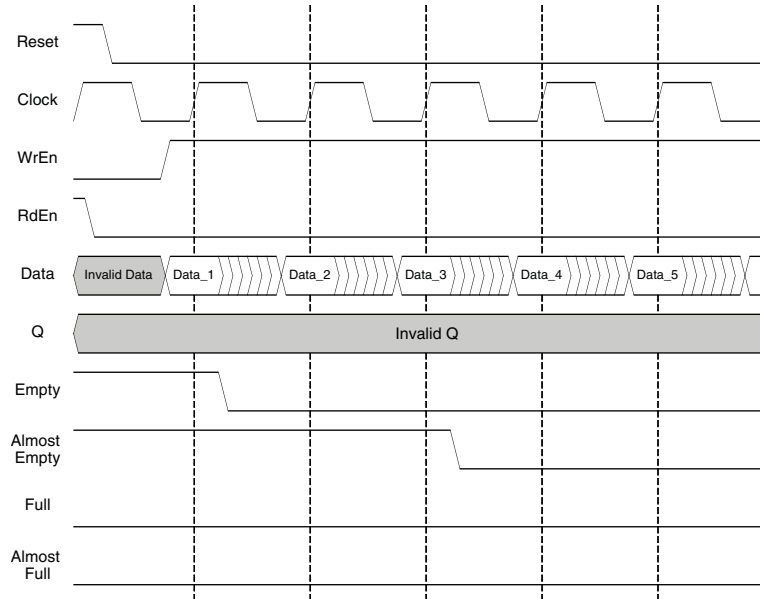


Figure 11-26. FIFO with Output Registers, End of Data Write Cycle

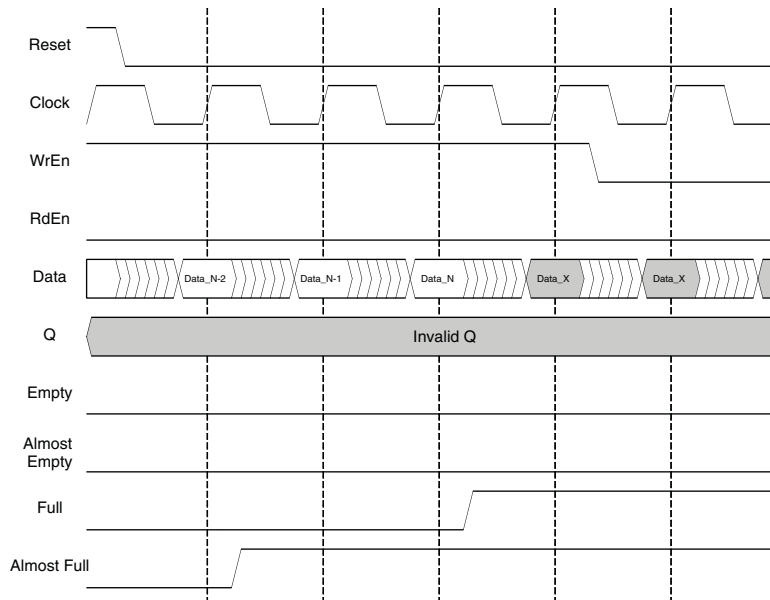


Figure 11-27. FIFO with Output Registers, Start of Data Read Cycle

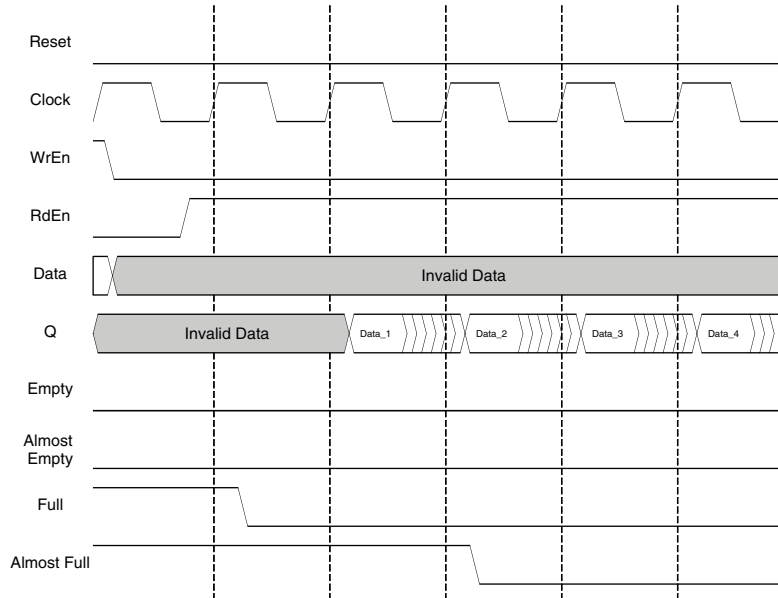
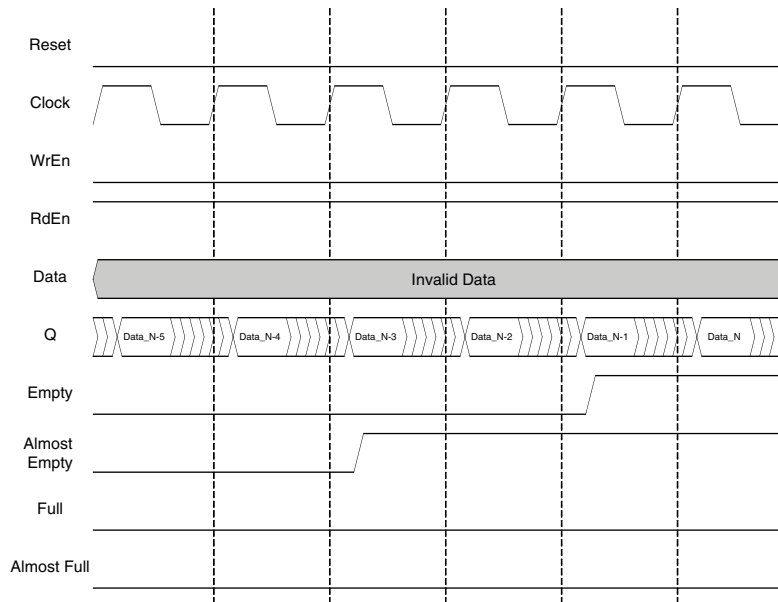
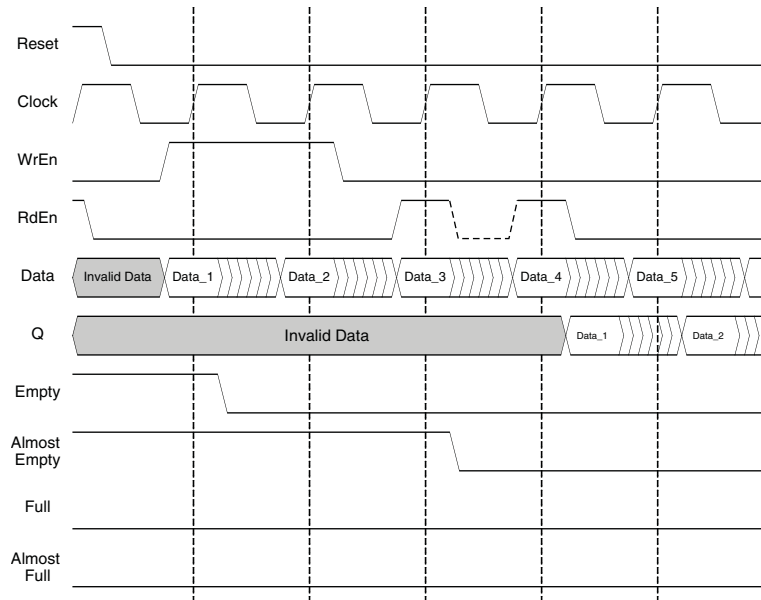


Figure 11-28. FIFO with Output Registers, End of Data Read Cycle



And finally, if you select the option enable output register with RdEn, it still delays the data out by one clock cycle (as compared to the non-pipelined FIFO). The RdEn should also be high during that clock cycle, otherwise the data takes an extra clock cycle when the RdEn goes true.

Figure 11-29. FIFO with Output Registers and RdEn on Output Registers**Dual Clock First In First Out (FIFO_DC) Memory:**

The FIFO_DC or the dual clock FIFO is also an emulated FIFO. Again, the address logic and the flag logic is implemented in the FPGA fabric around the RAM.

The ports available on the FIFO_DC are:

- Reset
- RPRreset
- WrClock
- RdClock
- WrEn
- RdEn
- Data
- Q
- Full Flag
- Almost Full Flag
- Empty Flag
- Almost Empty Flag

FIFO_DC Flags

The FIFO_DC, as an emulated FIFO, required the flags to be implemented in the FPGA logic around the block RAM. Because of the two clocks, the flags were required to change clock domains from read clock to write clock and vice versa. This adds latency to the flags either during assertion or de-assertion. The latency can be avoided only in one of the cases (either assertion or de-assertion) or distributed among these cases.

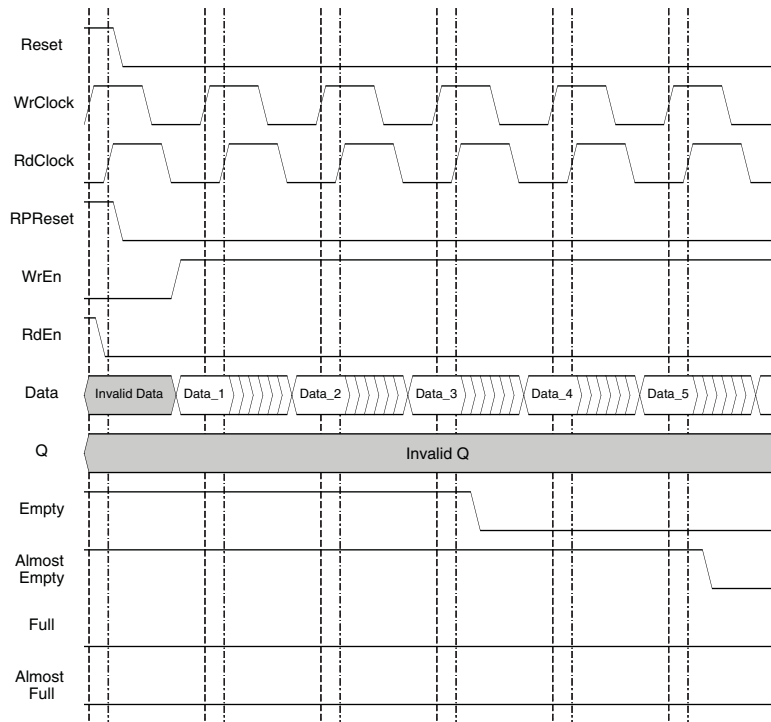
In the current emulated FIFO_DC, there is no latency during assertion of these flags which we feel is more important. Thus, when these flags are required to go true, there is no latency. However, due to the design of the flag logic running on two clock domains, there is latency during the de-assertion.

Let us assume that we start to write into the FIFO_DC to fill it. The write operation is controlled by WrClock and WrEn, however it takes extra RdClock cycles for de-assertion of the Empty and Almost Empty flags.

On the other hand, de-assertion of Full and Almost Full result in the reading out of the data from the FIFO_DC. It takes extra WrClock cycles, after reading this data, for the flags to come out.

With this in mind, let us look at the FIFO_DC without output registers waveforms. Figure 11-30 shows the operation of the FIFO_DC when it is empty and the data starts to be written into it.

Figure 11-30. FIFO_DC without Output Registers, Start of Data Write Cycle

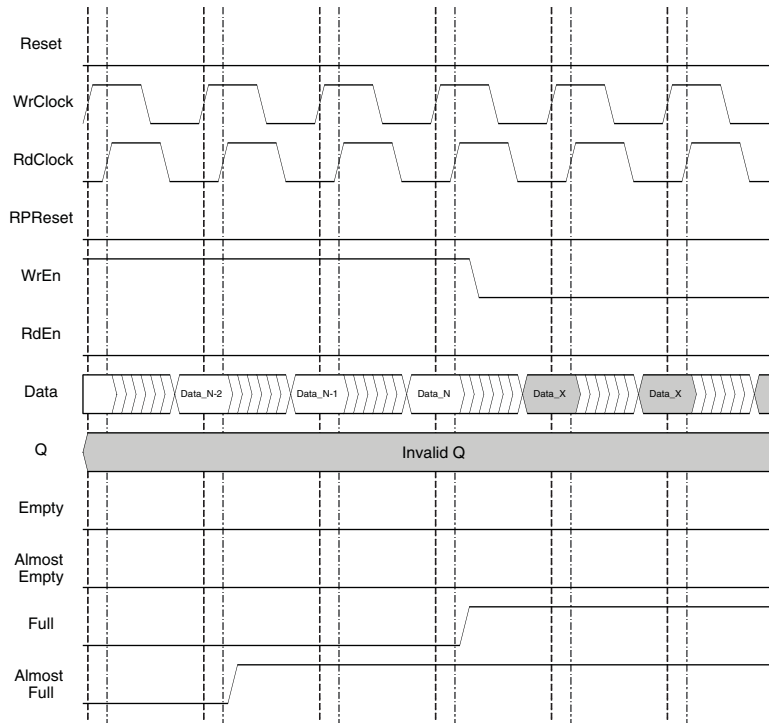


The WrEn signal must be high to start writing into the FIFO_DC. The Empty and Almost Empty flags are high to begin and Full and Almost full are low.

When the first data is written into the FIFO_DC, the Empty flag de-asserts (or goes low), as the FIFO_DC is no longer empty. In this figure we assume that the Almost Empty setting flag setting is 3 (address location 3). So the Almost Empty flag is de-asserted when the third address location is filled.

Now let us assume that we continue to write into the FIFO_DC to fill it. When the FIFO_DC is filled, the Almost Full and Full Flags are asserted. Figure 11-31 shows the behavior of these flags. In this figure the FIFO_DC depth is 'N'.

Figure 11-31. FIFO_DC without Output Registers, End of Data Write Cycle



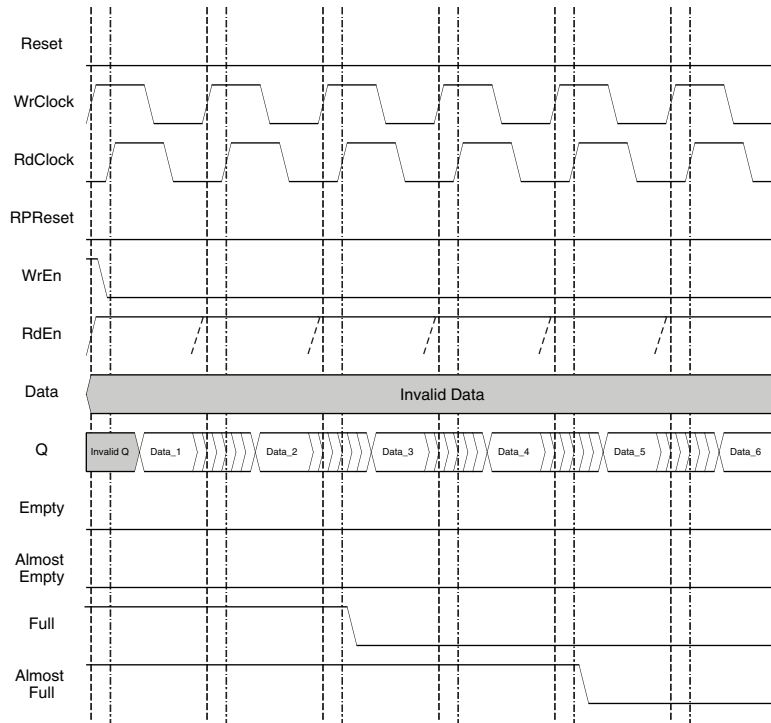
In this case, the Almost Full flag is in the 2 location before the FIFO_DC is filled. The Almost Full flag is asserted when the N-2 location is written, and the Full flag is asserted when the last word is written into the FIFO_DC.

Data_X data inputs do not get written as the FIFO_DC is full (the Full flag is high).

Note that the assertion of these flags is immediate and there is no latency when they go true.

Now let us look at the waveforms when the contents of the FIFO_DC are read out. Figure 11-32 shows the start of the read cycle. RdEn goes high and the data read starts. The Full and Almost Full flags are de-asserted, as shown. In this case, note that the de-assertion is delayed by two clock cycles.

Figure 11-32. FIFO_DC without Output Registers, Start of Data Read Cycle



Similarly, as the data is read out, and FIFO_DC is emptied, the Almost Empty and Empty flags are asserted.

Figure 11-33. FIFO_DC without Output Registers, End of Data Read Cycle

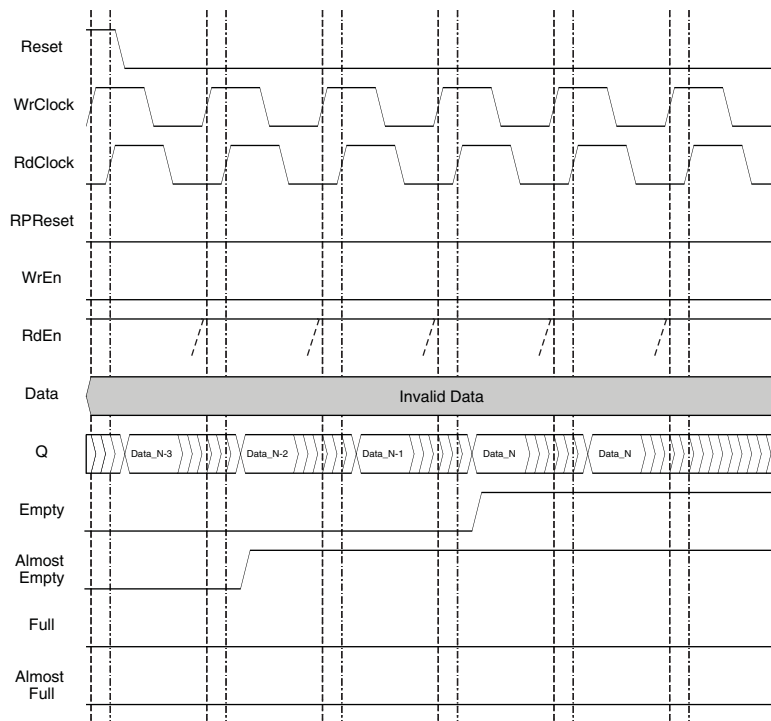


Figure 11-33 show the behavior of non-pipelined FIFO_DC or FIFO_DC without output registers. When we pipeline the registers, the output data is delayed by one clock cycle. There is an extra option for the output registers to be enabled by the RdEn signal.

Figures 11-34 to 11-37 show the similar waveforms for the FIFO_DC with output register and without output register enable with RdEn. Note that flags are asserted and de-asserted with similar timing to the FIFO_DC without output registers. However, it is only the data out 'Q' that is delayed by one clock cycle.

Figure 11-34. FIFO_DC with Output Registers, Start of Data Write Cycle

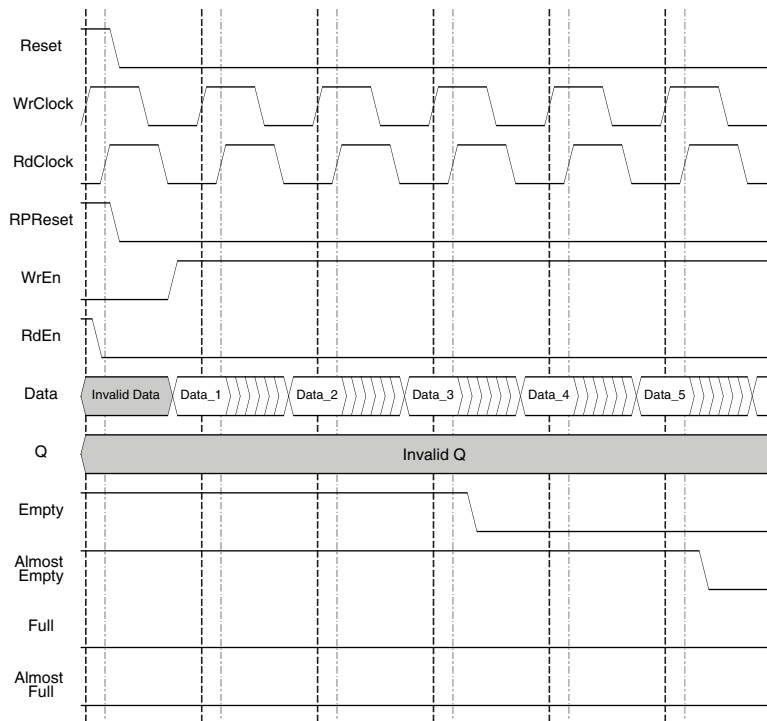


Figure 11-35. FIFO_DC with Output Registers, End of Data Write Cycle

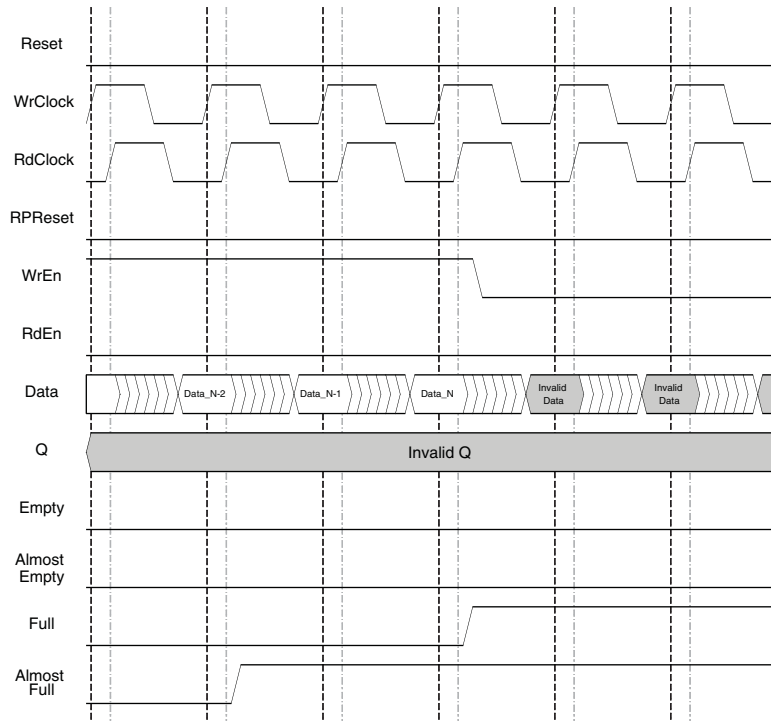


Figure 11-36. FIFO_DC with Output Registers, Start of Data Read Cycle

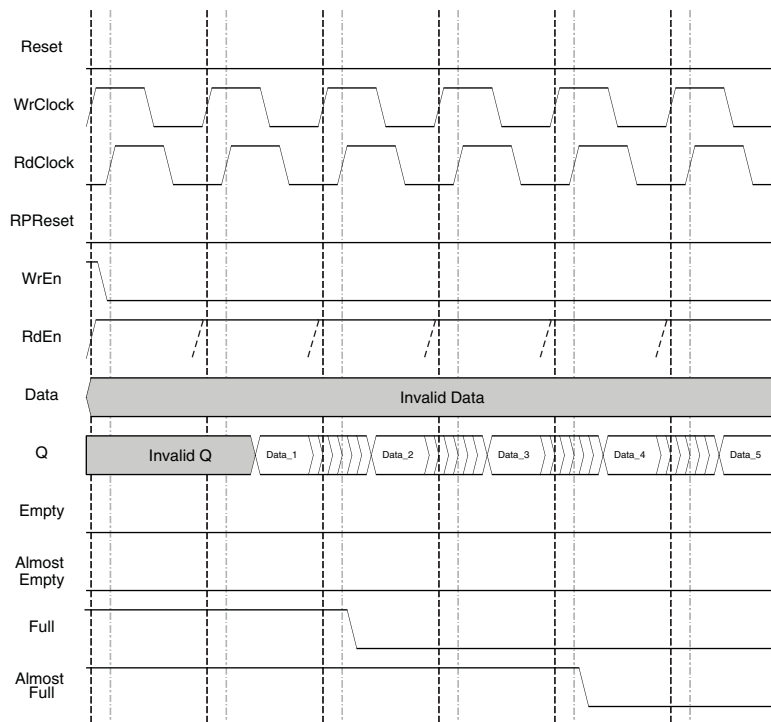
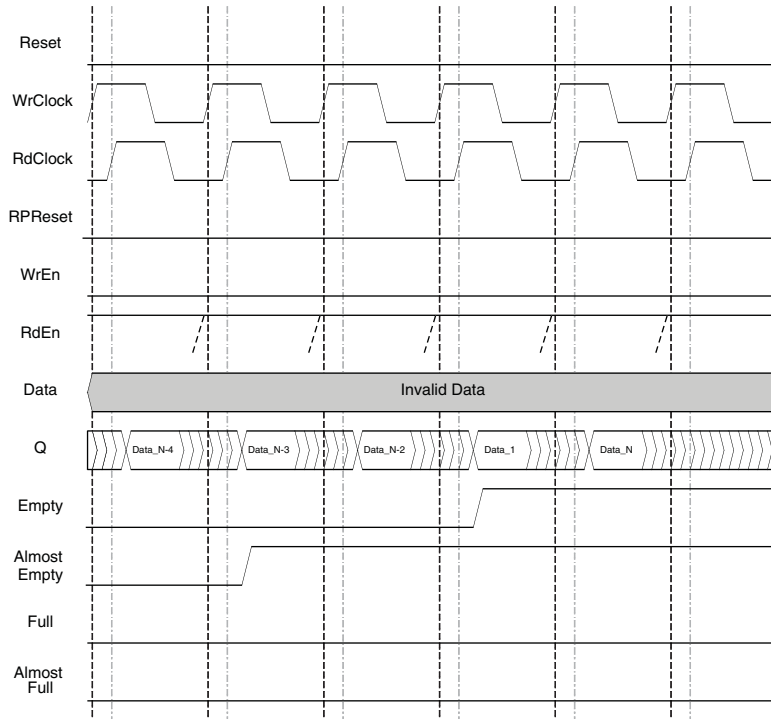
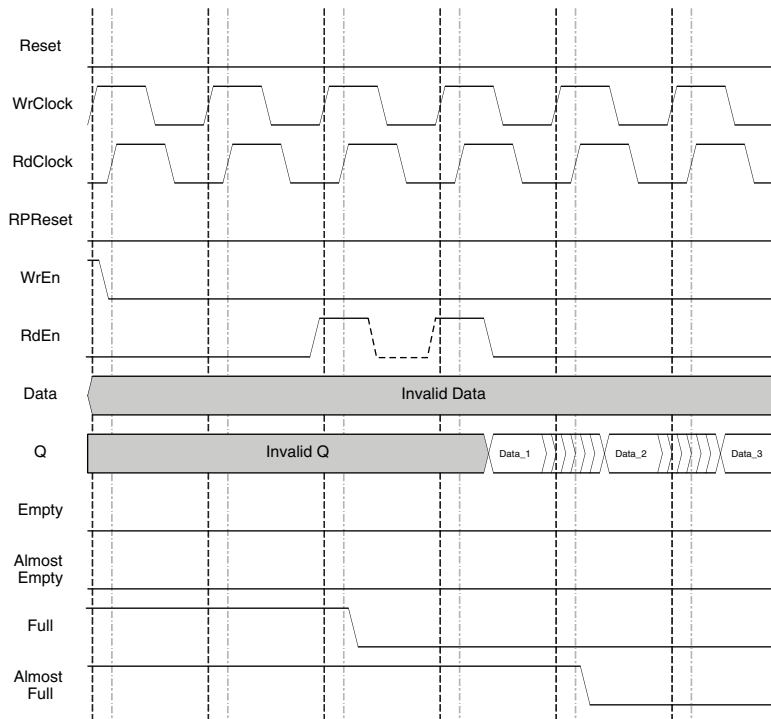


Figure 11-37. FIFO_DC with Output Registers, End of Data Read Cycle



And finally, if you select the option to enable the output register with RdEn, it still delays the data out by one clock cycle (as compared to the non-pipelined FIFO_DC). The RdEn should also be high during that clock cycle, otherwise the data takes an extra clock cycle when the RdEn is goes true.

Figure 11-38. FIFO_DC with Output Registers and RdEn on Output Registers

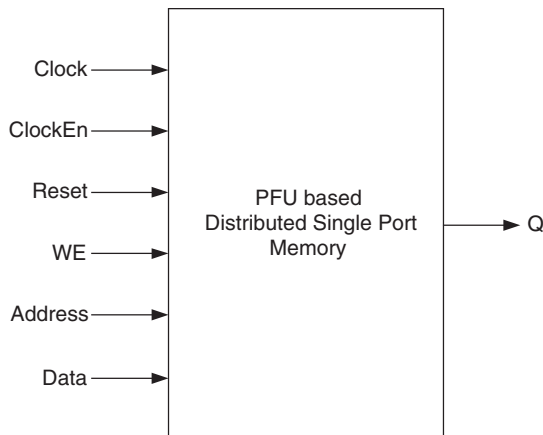


Distributed Single Port RAM (Distributed_SPRAM) – PFU Based

PFU-based Distributed Single Port RAM is created using the 4-input LUT (Look-Up Table) available in the PFU. These LUTs can be cascaded to create larger Distributed Memory sizes.

Figure 11-39 shows the Distributed Single Port RAM module as generated by IPexpress.

Figure 11-39. Distributed Single Port RAM Module Generated by IPexpress



The generated module makes use 4-input LUT available in the PFU. Additional logic like Clock, Reset is generated by utilizing the resources available in the PFU.

Ports such as Read Clock (RdClock) and Read Clock Enable (RdClockEn), are not available in the hardware primitive. These are generated by IPexpress when the user wants the to enable the output registers in their IPexpress configuration.

The various ports and their definitions for the memory are as per Table 11-14. The table lists the corresponding ports for the module generated by IPexpress and for the primitive.

Table 11-14. PFU-based Distributed Single Port RAM Port Definitions

| Port Name in Generated Module | Port Name in the PFU Primitive | Description | Active State |
|-------------------------------|--------------------------------|--------------|-------------------|
| Clock | CK | Clock | Rising Clock Edge |
| ClockEn | — | Clock Enable | Active High |
| Reset | — | Reset | Active High |
| WE | WRE | Write Enable | Active High |
| Address | AD[3:0] | Address | — |
| Data | DI[1:0] | Data In | — |
| Q | DO[1:0] | Data Out | — |

Ports such as Clock Enable (ClockEn) are not available in the hardware primitive. These are generated by IPexpress when the user wishes to enable the output registers in the IPexpress configuration.

Users have the option of enabling the output registers for Distributed Single Port RAM (Distributed_SPRAM). Figures 11-40 and 11-41 show the internal timing waveforms for the Distributed Single Port RAM (Distributed_SPRAM) with these options.

Figure 11-40. PFU Based Distributed Single Port RAM Timing Waveform – without Output Registers

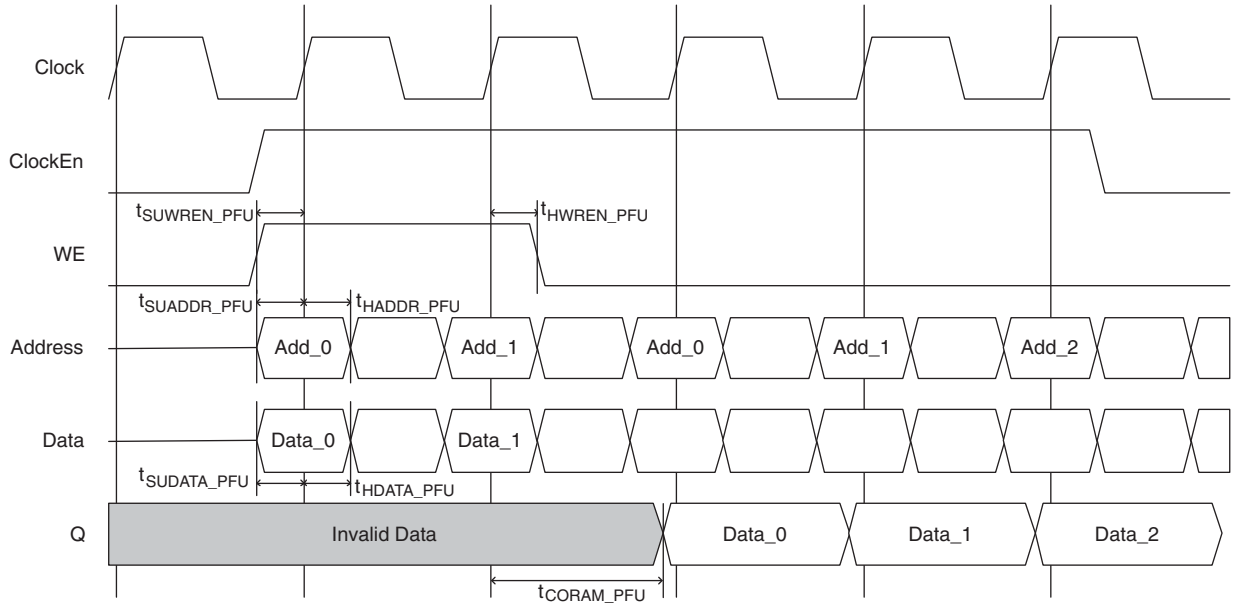
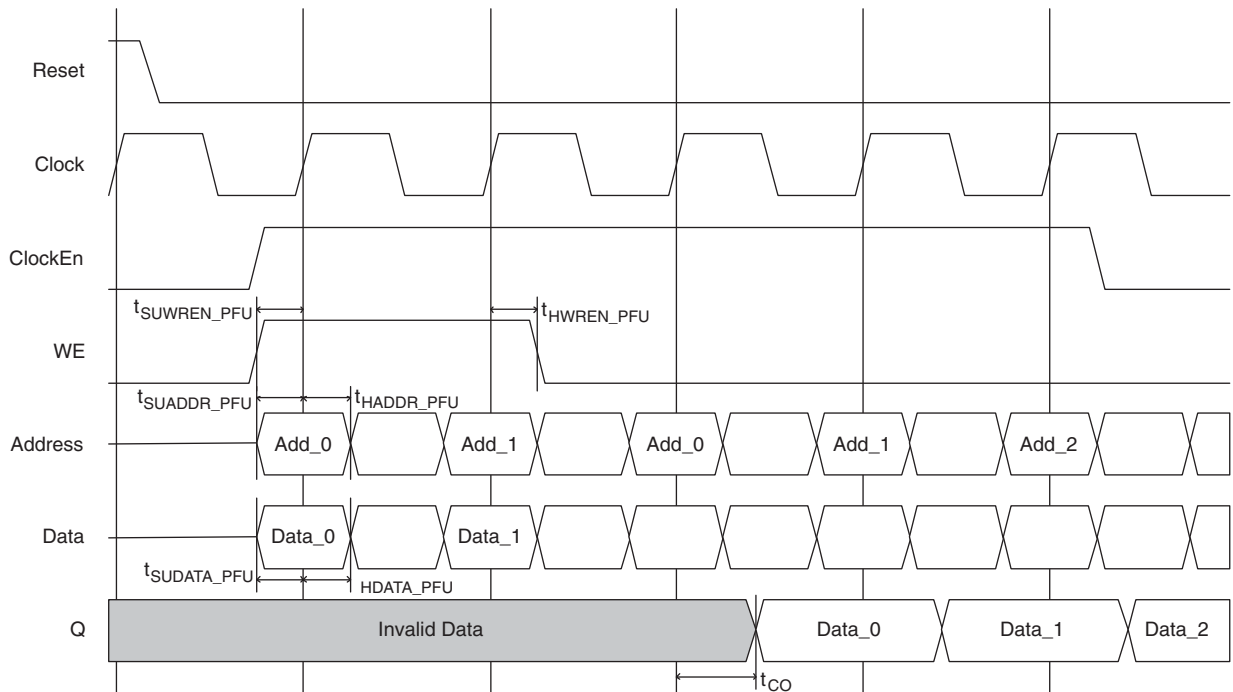


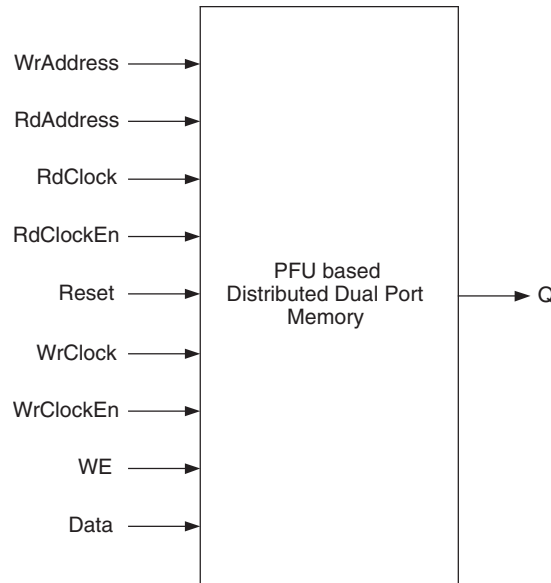
Figure 11-41. PFU Based Distributed Single Port RAM Timing Waveform – with Output Registers



Distributed Dual Port RAM (Distributed_DPRAM) – PFU Based

PFU-based Distributed Dual Port RAM is also created using the 4-input LUT (Look-Up Table) available in the PFU. These LUTs can be cascaded to create a larger Distributed Memory sizes.

Figure 11-42. Distributed Dual Port RAM Module Generated by IPexpress



The generated module makes use of the 4-input LUT available in the PFU. Additional logic like Clock and Reset is generated by utilizing the resources available in the PFU.

Ports such as Read Clock (RdClock) and Read Clock Enable (RdClockEn), are not available in the hardware primitive. These are generated by IPexpress when the user wants to enable the output registers in the IPexpress configuration.

The various ports and their definitions for memory are as per Table 11-15. The table lists the corresponding ports for the module generated by IPexpress and for the primitive.

Table 11-15. PFU-based Distributed Dual-Port RAM Port Definitions

| Port Name in Generated Module | Port Name in the EBR Block Primitive | Description | Active State |
|-------------------------------|--------------------------------------|--------------------|-------------------|
| WrAddress | WAD[3:0] | Write Address | — |
| RdAddress | RAD[3:0] | Read Address | — |
| RdClock | — | Read Clock | Rising Clock Edge |
| RdClockEn | — | Read Clock Enable | Active High |
| WrClock | WCK | Write Clock | Rising Clock Edge |
| WrClockEn | — | Write Clock Enable | Active High |
| WE | WRE | Write Enable | Active High |
| Data | DI[1:0] | Data Input | — |
| Q | RDO[1:0] | Data Out | — |

Ports such as Read Clock (RdClock) and Read Clock Enable (RdClockEn) are not available in the hardware primitive. These are generated by IPexpress when the user wants to enable the output registers in the IPexpress configuration.

Users have the option of enabling the output registers for Distributed Dual Port RAM (Distributed_DPRAM). Figures 11-43 and 11-44 show the internal timing waveforms for the Distributed Dual Port RAM (Distributed_DPRAM) with these options.

Figure 11-43. PFU Based Distributed Dual Port RAM Timing Waveform – without Output Registers

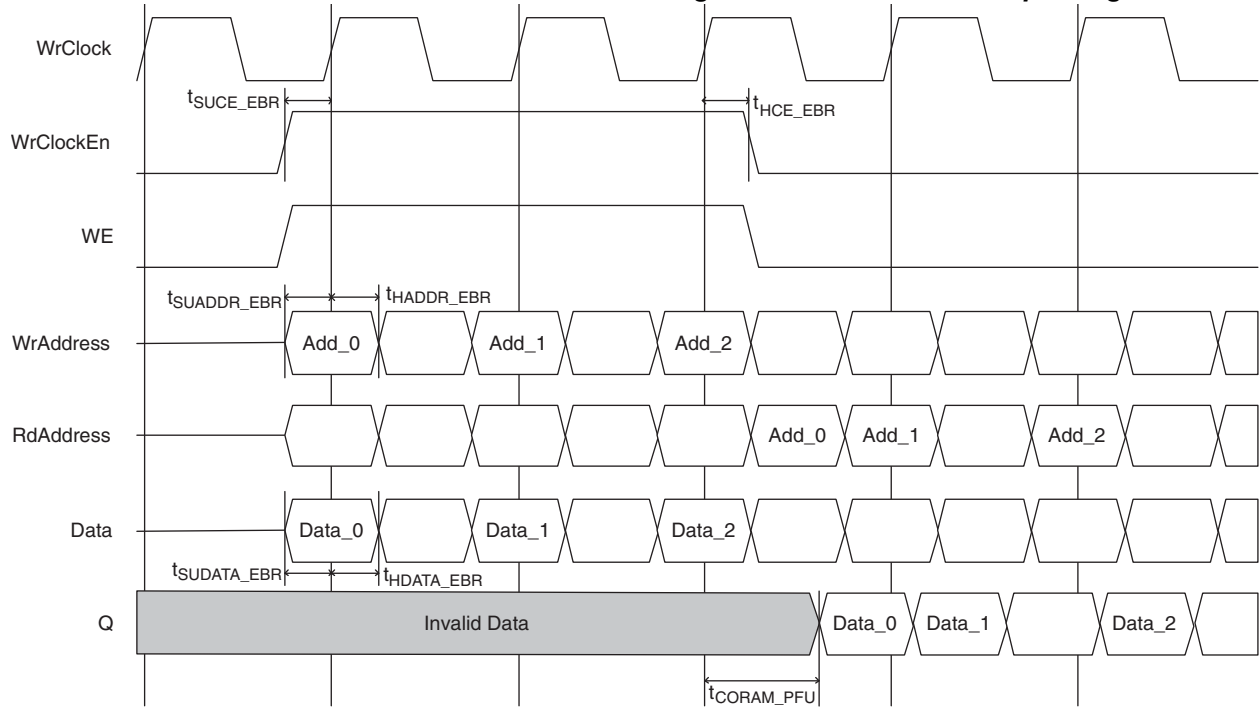
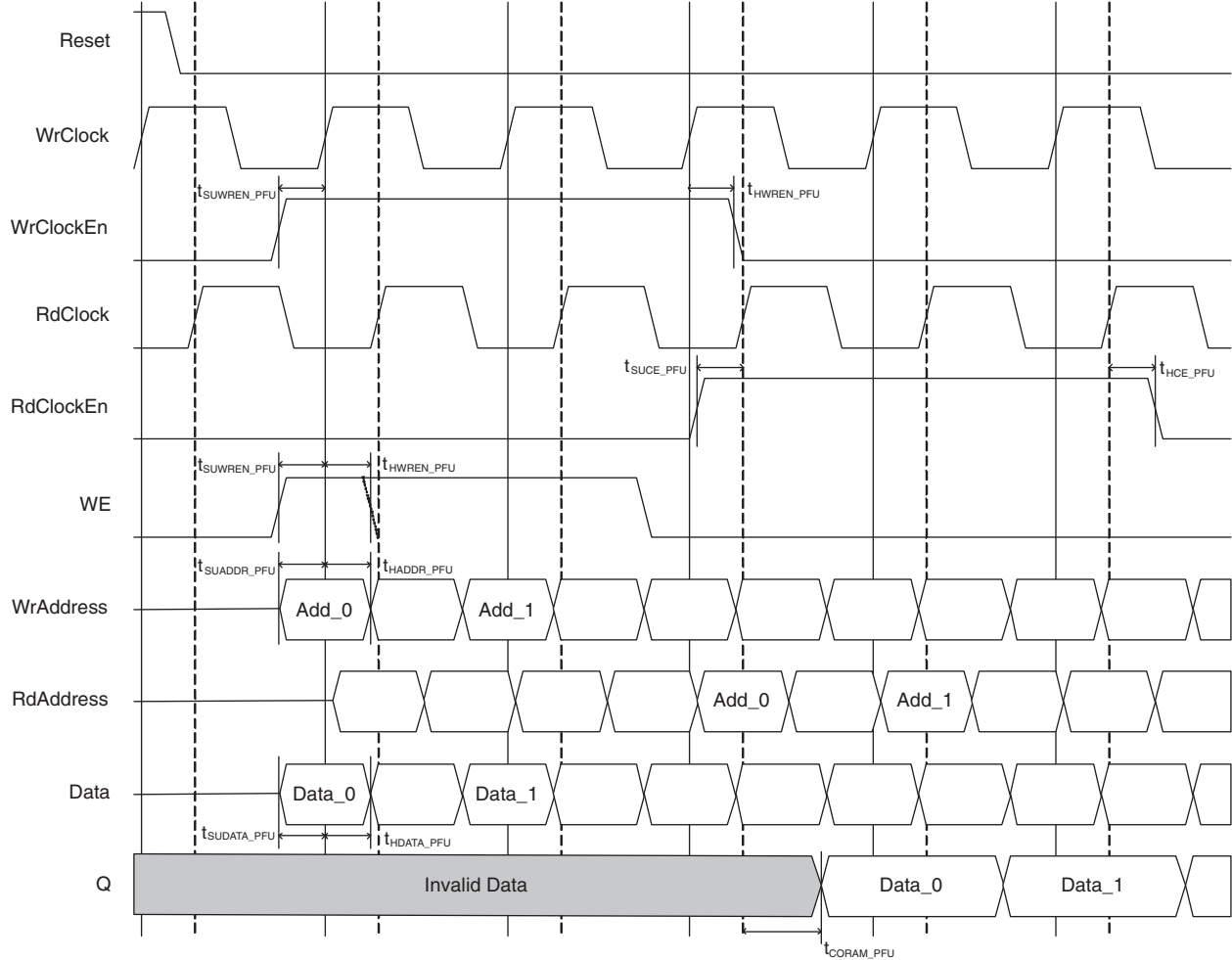


Figure 11-44. PFU Based Distributed Dual Port RAM Timing Waveform – with Output Registers

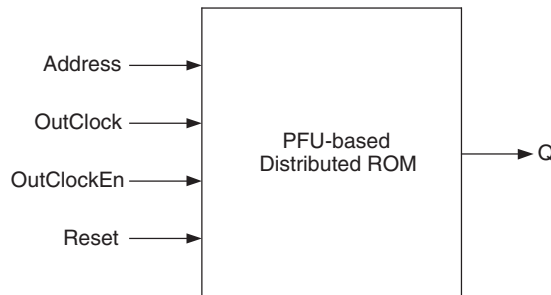


Distributed ROM (Distributed_ROM) – PFU Based

PFU-based Distributed ROM is also created using the 4-input LUT (Look-Up Table) available in the PFU. These LUTs can be cascaded to create larger Distributed Memory sizes.

Figure 11-45 shows the Distributed ROM module as generated by IPexpress.

Figure 11-45. Distributed ROM Generated by IPexpress



The generated module makes use of the 4-input LUT available in the PFU. Additional logic like Clock and Reset is generated by utilizing the resources available in the PFU.

Ports such as Out Clock (OutClock) and Out Clock Enable (OutClockEn) are not available in the hardware primitive. These are generated by IPexpress when the user wants to enable the output registers in the IPexpress configuration.

The various ports and their definitions for memory are as per Table 11-16. The table lists the corresponding ports for the module generated by IPexpress and for the primitive.

Table 11-16. PFU-based Distributed ROM Port Definitions

| Port Name in Generated Module | Port Name in the PFU Block Primitive | Description | Active State |
|-------------------------------|--------------------------------------|------------------|-------------------|
| Address | AD[3:0] | Address | — |
| OutClock | — | Out Clock | Rising Clock Edge |
| OutClockEn | — | Out Clock Enable | Active High |
| Reset | — | Reset | Active High |
| Q | DO | Data Out | — |

Users have the option to enable the output registers for Distributed ROM (Distributed_ROM). Figures 11-46 and 11-47 show the internal timing waveforms for the Distributed ROM with these options.

Figure 11-46. PFU Based ROM Timing Waveform – without Output Registers

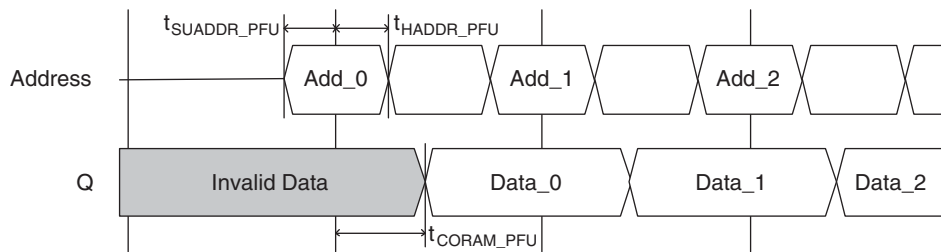
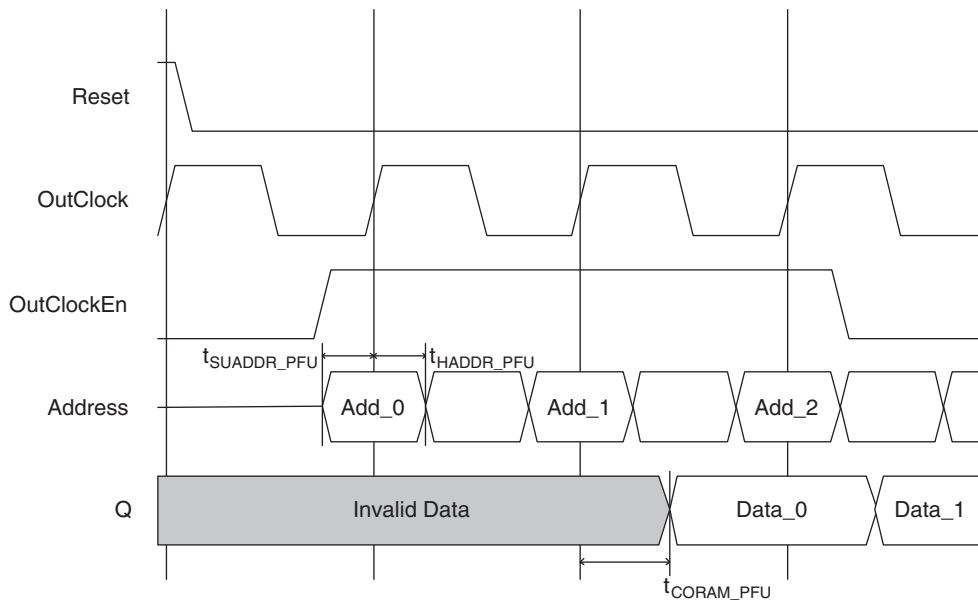


Figure 11-47. PFU Based ROM Timing Waveform – with Output Registers



Initializing Memory

In the EBR based ROM or RAM memory modes and the PFU based ROM memory mode, it is possible to specify the power-on state of each bit in the memory array. Each bit in the memory array can have one of two values: 0 or 1.

Initialization File Format

The initialization file is an ASCII file, which users can create or edit using any ASCII editor. IPexpress supports three types of memory file formats:

- Binary file
- Hex File
- Addressed Hex

The file name for the memory initialization file is *.mem (<file_name>.mem). Each row depicts the value to be stored in a particular memory location and the number of characters (or the number of columns) represents the number of bits for each address (or the width of the memory module).

The Initialization File is primarily used for configuring the ROMs. The EBR in RAM mode can optionally use this Initialization File also to preload the memory contents.

Binary File

The file is essentially a text file of 0's and 1's. The rows indicate the number of words and columns indicate the width of the memory.

```
Memory Size 20x32
00100000010000000010000001000000
00000001000000010000000100000001
000000100000000100000001000000010
000000110000000110000001100000011
00000100000001000000010000000100
00000101000001010000010100000101
00000110000001100000011000000110
00000111000001110000011100000111
00001000010010000000100001001000
000010010100100100000100101001001
000010100100101000000101001001010
000010110100101100000101101001011
00001100000011000000110000001100
00001101001011010000110100101101
00001110001111100000111000111110
00001111001111110000111100111111
00010000000100000001000000010000
00010001000100010001000100010001
00010010000100100001001000010010
00010011000100110001001100010011
```

Hex File

The Hex file is essentially a text file of Hex characters arranged in a similar row-column arrangement. The number of rows in the file is same as the number of address locations, with each row indicating the content of the memory location.

```
Memory Size 8x16
A001
0B03
1004
CE06
0007
040A
0017
02A4
```

Addressed Hex

Addressed Hex consists of lines of address and data. Each line starts with an address, followed by a colon, and any number of data. The format of memfile is address: data data data data ... where address and data are hexadecimal numbers.

```
-A0 : 03 F3 3E 4F
-B2 : 3B 9F
```

The first line puts 03 at address A0, F3 at address A1, 3E at address A2, and 4F at address A3. The second line puts 3B at address B2 and 9F at address B3.

There is no limitation on the values of address and data. The value range is automatically checked based on the values of `addr_width` and `data_width`. If there is an error in an address or data value, an error message is printed. Users need not specify data at all address locations. If data is not specified at certain address, the data at that location is initialized to 0. IPexpress makes memory initialization possible both through the synthesis and simulation flows.

Technical Support Assistance

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 +1-503-268-8001 (Outside North America)
e-mail: techsupport@latticesemi.com
Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|---|
| February 2006 | 01.0 | Initial release. |
| April 2006 | 01.1 | Updated the Initializing Memory section |
| September 2006 | 01.2 | Added LatticeECP2M device information. Added dual port memory access notes. |
| April 2007 | 01.3 | Updated Utilizing IPexpress section. |
| February 2008 | 01.4 | Updated Pseudo-Dual Port RAM Attributes for LatticeECP2/M table. |
| March 2008 | 01.5 | Updated FIFO_DC without Output Registers (Non-Pipelined) figure. |
| June 2008 | 01.6 | Updated First In First Out (FIFO, FIFO_DC) – EBR Based section. Removed Read-Before-Write sysMEM EBR mode. |
| August 2008 | 01.7 | Corrected AddressA, AddressB information in EBR-based True Dual Port Memory Port Definitions table. |
| September 2008 | 01.8 | Updated IPexpress Flow text section. |
| March 2009 | 01.9 | Updated Memory Modules text section. |
| July 2011 | 02.0 | Added the setup and hold requirements for addresses to EBR-based memories. |

Appendix A. Attribute Definitions

DATA_WIDTH

Data width is associated with the RAM and FIFO elements. The DATA_WIDTH attribute will define the number of bits in each word. It takes the values as defined in the RAM size tables in each memory module.

REGMODE

REGMODE or the Register mode attribute is used to enable pipelining in the memory. This attribute is associated with the RAM and FIFO elements. The REGMODE attribute takes the NOREG or OUTREG mode parameter that disables and enables the output pipeline registers.

RESETMODE

The RESETMODE attribute allows users to select the mode of reset in the memory. This attribute is associated with the block RAM elements. RESETMODE takes two parameters: SYNC and ASYNC. SYNC means that the memory reset is synchronized with the clock. ASYNC means that the memory reset is asynchronous to clock.

CSDECODE

CSDECODE or the Chip Select Decode attributes are associated to block RAM elements. CS, or Chip Select, is the port available in the EBR primitive that is useful when memory requires multiple EBR blocks cascaded. The CS signal forms the MSB for the address when multiple EBR blocks are cascaded. CS is a 3-bit bus, so it can cascade eight memories easily. CSDECODE takes the following parameters: "000", "001", "010", "011", "100", "101", "110", and "111". CSDECODE values determine the decoding value of CS[2:0]. CSDECODE_W is chip select decode for write and CSDECODE_R is chip select decode for read for Pseudo Dual Port RAM. CSDECODE_A and CSDECODE_B are used for true dual port RAM elements and refer to the A and B ports.

WRITEMODE

The WRITEMODE attribute is associated with the block RAM elements. It takes the NORMAL and WRITE-THROUGH mode parameters.

In NORMAL mode, the output data does not change or get updated, during the write operation. This mode is supported for all data widths.

In WRITETHROUGH mode, the output data is updated with the input data during the write cycle. This mode is supported for all data widths.

WRITEMODE_A and WRITEMODE_B are used for dual port RAM elements and refer to the A and B ports in case of a True Dual Port RAM.

For all modes (of the True Dual Port module), simultaneous read access from one port and write access from the other port to the same memory address is not recommended. The read data may be unknown in this situation. Also, simultaneous write access to the same address from both ports is not recommended. (When this occurs, the data stored in the address becomes undetermined when one port tries to write a 'H' and the other tries to write a 'L').

It is recommended that the designer implements control logic to identify this situation if it occurs and either:

1. Implement status signals to flag the read data as possibly invalid, or
2. Implement control logic to prevent the simultaneous access from both ports.

GSR

GSR or the Global Set/ Reset attribute is used to enable or disable the global set/reset for RAM element.

Introduction

LatticeECP2™ and LatticeECP2M™ devices support Double Data Rate (DDR) and Single Data Rate (SDR) interfaces using the logic built into the Programmable I/O (PIO). SDR applications capture data on one edge of a clock while the DDR interfaces capture data on both the rising and falling edges of the clock, thus doubling performance. The LatticeECP2/M I/Os also have dedicated circuitry to support DDR and DDR2 SDRAM memory interfaces. This technical note details the use of LatticeECP2/M devices to implement both a high-speed generic DDR interface and DDR and DDR2 memory interfaces.

DDR and DDR2 SDRAM Interfaces Overview

A DDR SDRAM interface will transfer data at both the rising and falling edges of the clock. The DDR2 is the second generation of the DDR SDRAM memory.

The DDR and DDR2 SDRAM interfaces rely on the use of a data strobe signal, called DQS, for high-speed operation. The DDR SDRAM interface uses a single-ended DQS strobe signal, whereas the DDR2 interface uses a differential DQS strobe. Figures 12-1 and 12-2 show typical DDR and DDR2 SDRAM interface signals. SDRAM interfaces are typically implemented with eight DQ data bits per DQS. An x16 interface will use two DQS signals and each DQS is associated with eight DQ bits. Both the DQ and DQS are bi-directional ports used to both read and write to the memory.

When reading data from the external memory device, data coming into the device is edge-aligned with respect to the DQS signal. This DQS strobe signal needs to be phase-shifted 90 degrees before FPGA logic can sample the read data. When writing to a DDR/DDR2 SDRAM, the memory controller (FPGA) must shift the DQS by 90 degrees to center-align with the data signals (DQ). A clock signal is also provided to the memory. This clock is provided as a differential clock (CLKP and CLKN) to minimize duty cycle variations. The memory also uses these clock signals to generate the DQS signal during a read via a DLL inside the memory. Figures 12-3 and 12-4 show DQ and DQS timing relationships for read and write cycles. For other detailed timing requirements, please refer to the DDR SDRAM JEDEC specification (JESD79C).

During read, the DQS signal is LOW for some duration after it comes out of tristate. This state is called Preamble. The state when the DQS is LOW before it goes into Tristate is the Postamble state. This is the state after the last valid data transition.

DDR SDRAM also requires a Data Mask (DM) signal to mask data bits during write cycles. Note that the ratio of DQS to data bits is independent of the overall width of the memory. An 8-bit interface will have one strobe signal.

DDR SDRAM interfaces use the SSTL25 Class I/II I/O standards whereas the DDR2 SDRAM interface uses the SSTL18 Class I/II I/O standards. The DDR2 SDRAM interface also supports differential DQS (DQS and DQS#).

Figure 12-1. Typical DDR SDRAM Interface

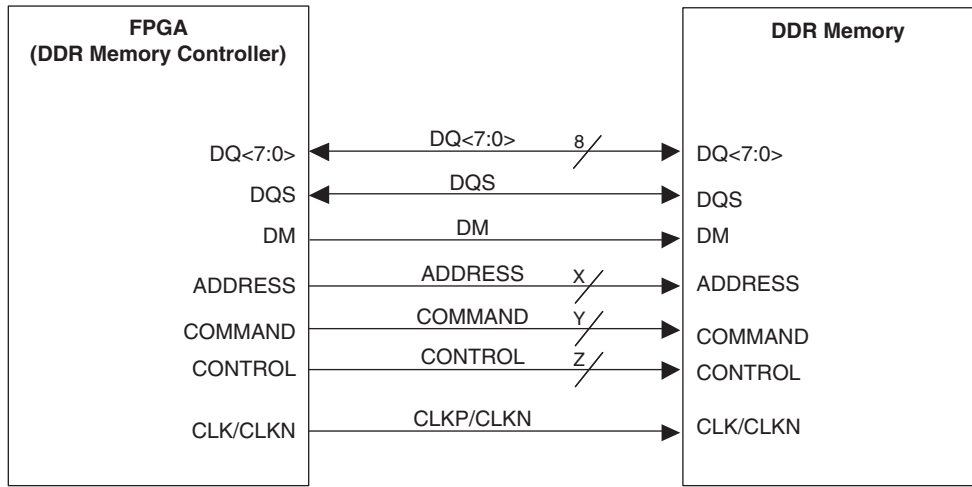
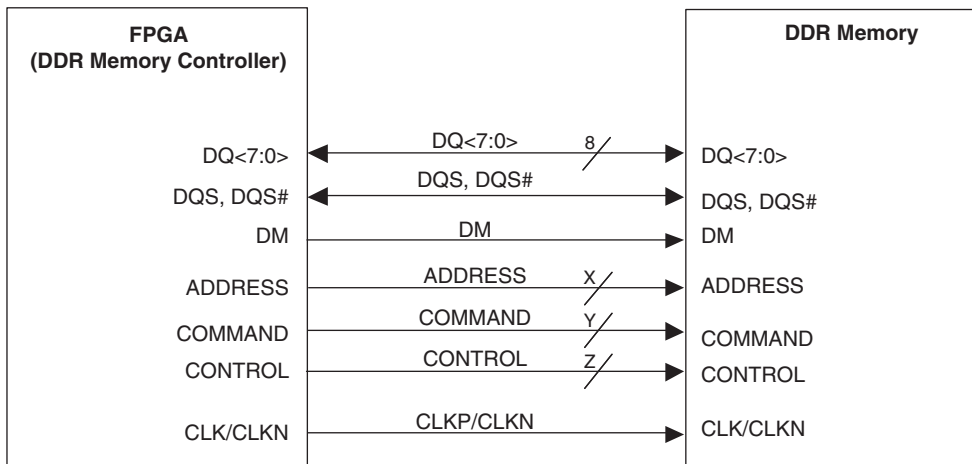


Figure 12-2. Typical DDR2 SDRAM Interface



The following two figures show the DQ and DQS relationship for memory read and write interfaces.

Figure 12-3. DQ-DQS During READ

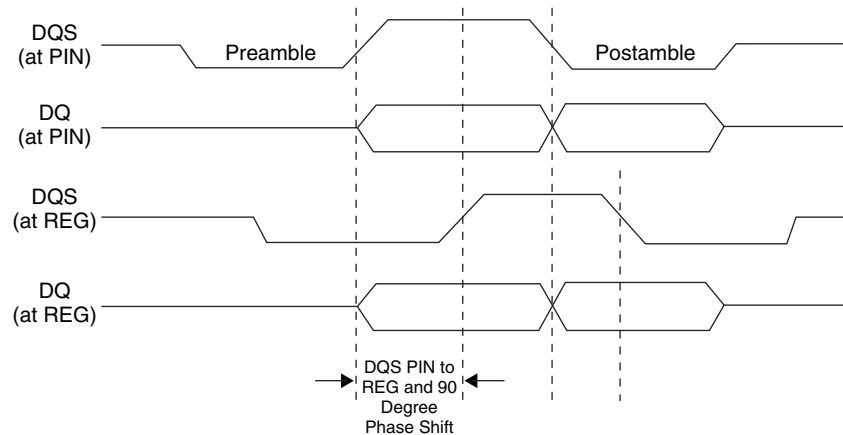
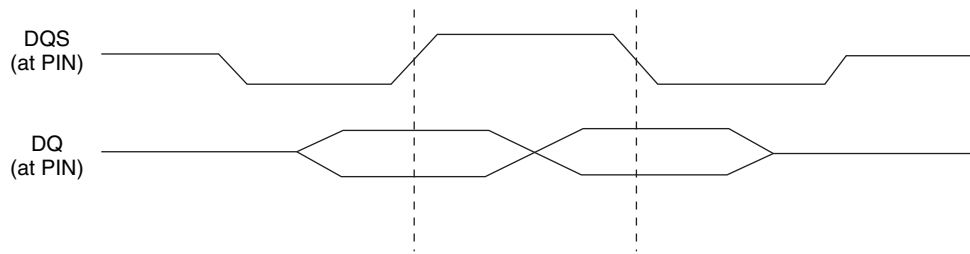


Figure 12-4. DQ-DQS During WRITE



Implementing DDR Memory Interfaces with LatticeECP2/M Devices

As described in the DDRSDRAM overview section, the DDR SDRAM interfaces rely primarily on the use of a data strobe signal called DQS for high-speed operation. When reading data from the external memory device, data coming into the LatticeECP2/M device is edge-aligned with respect to the DQS signal. Therefore, the LatticeECP2/M device needs to shift the DQS (a 90-degree phase shift) before using it to sample the read data. When writing to a DDR SDRAM, the memory controller from the LatticeECP2/M device must generate a DQS signal that is center-aligned with the DQ, the data signals. This is accomplished by ensuring the DQS strobe is 90 degrees ahead relative to DQ data.

LatticeECP2/M devices have dedicated DQS support circuitry for generating the appropriate phase shifting for DQS. The DQS phase shift circuit uses a frequency reference DLL to generate delay control signals associated with each of the dedicated DQS pins and is designed to compensate for process, voltage and temperature (PVT) variations. The frequency reference is provided through one of the global clock pins.

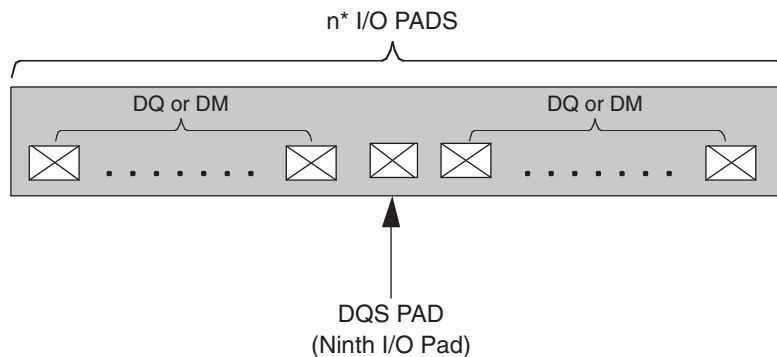
The dedicated DDR support circuit is also designed to provide comfortable and consistent margins for data sampling window.

This section describes how to implement the read and write sections of a DDR memory interface. It also provides details of the DQ and DQS grouping rules associated with the LatticeECP2/M devices.

DQS Grouping

Each DQS group generally consists of at least 10 I/Os (one DQS, eight DQ and one DM) to implement a complete 8-bit DDR memory interface. LatticeECP2/M devices support DQS signals on the bottom, left and right sides of the device. Each DQS signal on the bottom half of the device will span across 18 I/Os and on the left and right sides of the device will span across 16 I/Os. Any 10 of these I/Os spanned by the DQS can be used to implement an 8-bit DDR memory interface.

Figure 12-5. DQ-DQS Grouping



*n=18 on bottom banks and n=16 on the left and right side banks.

Figure 12-5 shows a typical DQ-DQS group for a LatticeECP2/M device. The ninth I/O of this group of 16 I/Os (on the left and right side banks) and 18 I/Os (on the bottom bank) is the dedicated DQS pin. All eight pads before of the DQS and 7 (on the left and right side) and 9 (on the bottom bank) pads after the DQS are covered by this DQS bus span. The user can assign any eight of these I/O pads to be DQ data pins. Therefore, to implement a 32-bit wide memory interface you would need to use four such DQ-DQS groups.

When not interfacing with the memory, the dedicated DQS pin can be used as a general purpose I/O. Each of the dedicated DQS pins is internally connected to the DQS phase shift circuitry. The pinout information contained in the [LatticeECP2/M Family Data Sheet](#) shows pin locations for the DQS pads. Table 12-1 shows an extract from the data sheet.

In this case, the DQS is marked as LDQS8 (L = left side, 8 = associated PFU row/column). Since DQS is always the fifth True Pad in the DQ-DQS group, counting from low to high PFU Row/Column number, LDQS6 will cover PL2A to PL11B. Following this convention, there are eight pads before and seven pads after DQS for DQ available following counter-clockwise for the left and bottom sides of the device and following clockwise for the top and right sides of the device. The user can assign any eight of these pads to be DQ data signals.

Table 12-1. ECP2-50 672 fpBGA Pinout from LatticeECP2/M Family Data Sheet

| Ball Number | Ball Function | Bank | Dual Function | Differential |
|-------------|---------------|------|---------------|--------------|
| D2 | PL2A | 7 | VREF2_7 | T* |
| D1 | PL2B | 7 | VREF1_7 | C* |
| GND | GNDIO | 7 | | |
| F6 | PL5A | 7 | | T |
| F5 | PL5B | 7 | | C |
| VCCIO | VCCIO | 7 | | |
| E4 | PL6A | 7 | | T* |
| E3 | PL6B | 7 | | C* |
| VCC | VCC | 7 | | |
| E2 | PL7A | 7 | | T |
| E1 | PL7B | 7 | | C |
| GND | GNDIO | 7 | | |
| GND | GND | 7 | | |
| H6 | PL8A | 7 | LDQS8 | T* |
| H5 | PL8B | 7 | | C* |
| F2 | PL9A | 7 | | T |
| VCCIO | VCCIO | 7 | | |
| F1 | PL9B | 7 | | C |
| H8 | PL10A | 7 | | T* |
| J9 | PL10B | 7 | | C* |
| G4 | PL11A | 7 | | T |
| GND | GNDIO | 7 | | |
| G3 | PL11B | 7 | | C |
| H7 | PL12A | 7 | | T* |
| VCCAUX | VCCAUX | 7 | | |

DDR Software Primitives

This section describes the software primitives that can be used to implement DDR interfaces. These primitives include:

- **DQSDLL** – The DQS delay calibration DLL
- **DQSBUFC** – The DQS delay function and the clock polarity selection logic
- **IDDRMX1A** – The DDR input and DQS to system clock transfer registers with half clock cycle transfer
- **IDDRMF1A** – The DDR input and DQS to system clock transfer registers with full clock cycle transfer
- **ODDRMXA** – The DDR output registers

HDL usage examples for each of these primitives are listed in Appendices A and B.

DQSDLL

The DQSDLL generates a 90-degree phase shift required for the DQS signal. This primitive implements the on-chip DQSDLL. Only one DQSDLL should be instantiated for all the DDR implementations on one half of the device. The clock input to this DLL should be at the same frequency as the DDR interface. The DLL generates the delay based on this clock frequency and the update control input to this block. The DLL updates the dynamic delay control to the DQS delay block when this update control (UDDCNTL) input is asserted. Figure 12-6 shows the primitive symbol. The active low signal on UDDCNTL updates the DQS phase alignment and should be initiated at the beginning of READ cycles.

Figure 12-6. DQSDLL Symbol

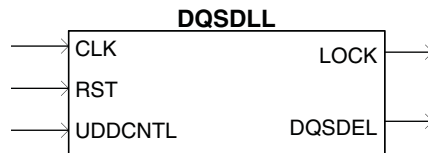


Table 12-2 provides a description of the ports.

Table 12-2. DQSDLL Ports

| Port Name | I/O | Description |
|-----------|-----|--|
| CLK | I | System CLK should be at the frequency of the DDR interface from the FPGA core. |
| RST | I | Resets the DQSDLL |
| UDDCNTL | I | Provides update signal to the DLL that will update the dynamic delay. |
| LOCK | O | Indicates when the DLL is in phase. |
| DQSDEL | O | The digital delay generated by the DLL, should be connected to the DQSBUF primitive. |

DQSDLL Update Control: The DQS Delay can be updated for PVT variation using the UDDCNTL input. The DQSDEL is updated when the when the UDDCNTL is held LOW. The DQSDEL can be updated when variations are expected. DQSDEL can be updated anytime, except when the memory controller is receiving data from the memory.

DQSDLL Configuration: By default, this DLL will generate a 90-degree phase shift for the DQS strobe based on the frequency of the input reference clock to the DLL. The user can control the sensitivity to jitter by using the LOCK_SENSITIVITY attribute. This configuration bit can be programmed to be either “HIGH” or “LOW”.

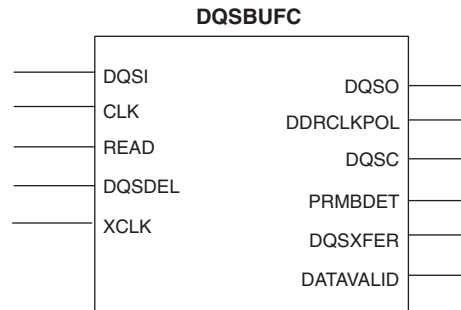
The DLL Lock Detect circuit has two modes of operation controlled by the LOCK_SENSITIVITY bit, which selects more or less sensitivity to jitter. If this DLL is operated at or above 150 MHz, it is recommended that the LOCK_SENSITIVITY bit be programmed “HIGH” (more sensitive). When running at or below 100 MHz, it is recom-

mended that the bit be programmed “LOW” (more tolerant). For 133 MHz, the LOCK_SENSITIVITY bit can go either way.

DQSBUFC

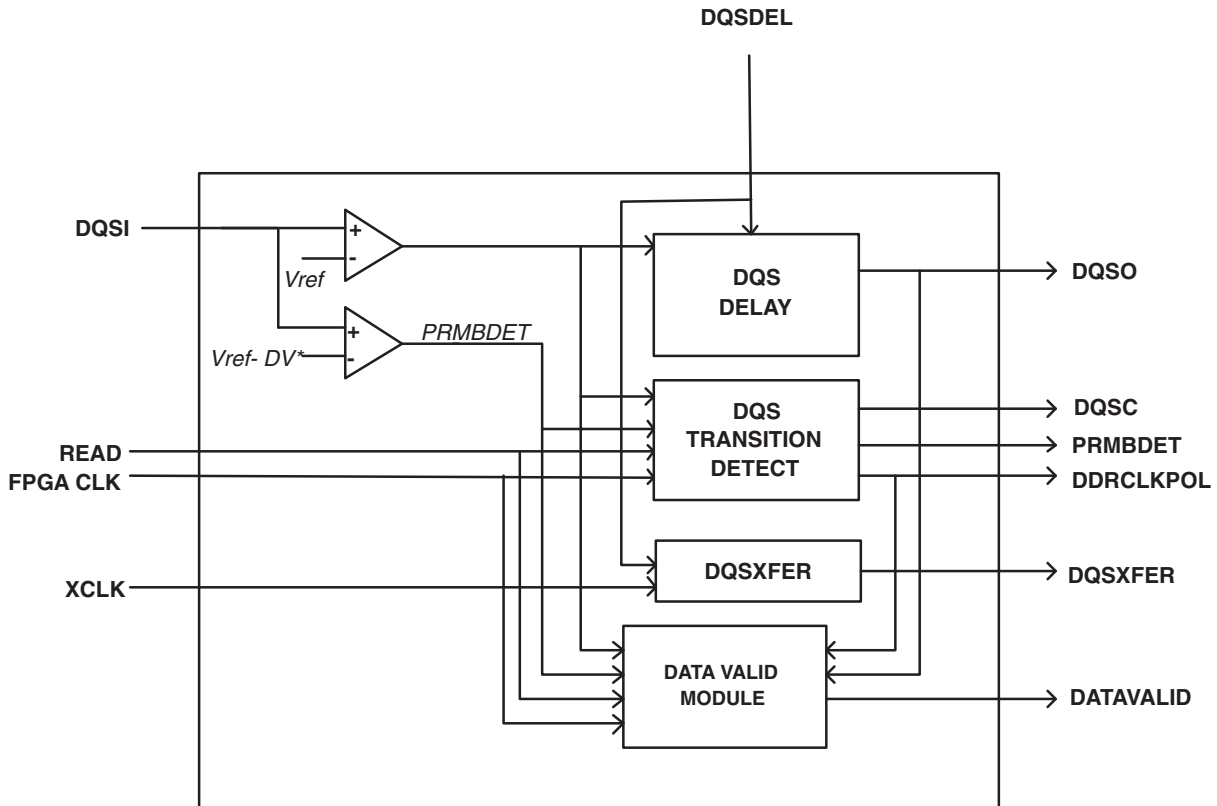
This primitive implements the DQS delay and the DQS transition detector logic. Figure 12-7 shows the primitive symbol.

Figure 12-7. DQSBUFC Symbol



The DQSBUFC is composed of the DQS Delay, the DQS Transition Detect and the DQSXFER block as shown in Figure 12-8. This block inputs the DQS and delays it by 90 degrees. It also generates the DDR Clock Polarity and the DQSXFER signal. The preamble detect (PRMBDET) signal is generated from the DQSI input using a voltage divider circuit.

Figure 12-8. DQSBUFC Function



*DV ~ 170mV for DDR1 (SSTL25 signaling)
*DV ~ 120mV for DDR2 (SSTL18 signaling)

DQS Delay Block: The DQS Delay block receives the digital control delay line (DQSDEL) coming from one of the two DQSDLL blocks. These control signals are used to delay the DQSI by 90 degrees. DQSO is the delayed DQS and is connected to the clock input of the first set of DDR registers.

DQS Transition Detect: The DQS Transition Detect block generates the DDR Clock Polarity signal based on the phase of the FPGA clock at the first DQS transition. The DDR READ control signal and FPGA CLK inputs to this coming and should be coming from the FPGA core.

DQSXFER: This block generates the 90-degree phase shifted clock to for the DDR Write interface. The input to this block is the XCLK. The user can choose to connect this either to the edge clock or the FPGA clocks. The DQSXFER is routed using the DQSXFER tree to all the I/Os spanned by that DQS.

Data Valid Module: The data valid module generates a DATAVALID signal. This signal indicates to the FPGA that valid data is transmitted out of the input DDR registers to the FPGA core.

Table 12-3 provides a description of the I/O ports associated with the DQSBUFC primitive.

Table 12-3. DQSBUFC Ports

| Port Name | I/O | Description |
|-----------|-----|--|
| DQSI | I | DQS Strobe signal from memory |
| CLK | I | System CLK |
| READ | I | Read generated from the FPGA core |
| DQSDEL | I | DQS Delay from the DQSDLL primitive |
| XCLK | I | Edge Clock or System CLK |
| DQSO | O | Delayed DQS Strobe signal, to the input capture register block |
| DQSC | O | DQS Strobe signal before delay, going to the FPGA core logic |
| DDRCLKPOL | O | DDR Clock Polarity signal |
| PRMBDET | O | Preamble detect signal, going to the FPGA core logic |
| DQSXFER | O | 90 degree shifted clock going to the Output DDR register Block |
| DATAVALID | O | Signal indicating transmission of Valid data to the FPGA core |

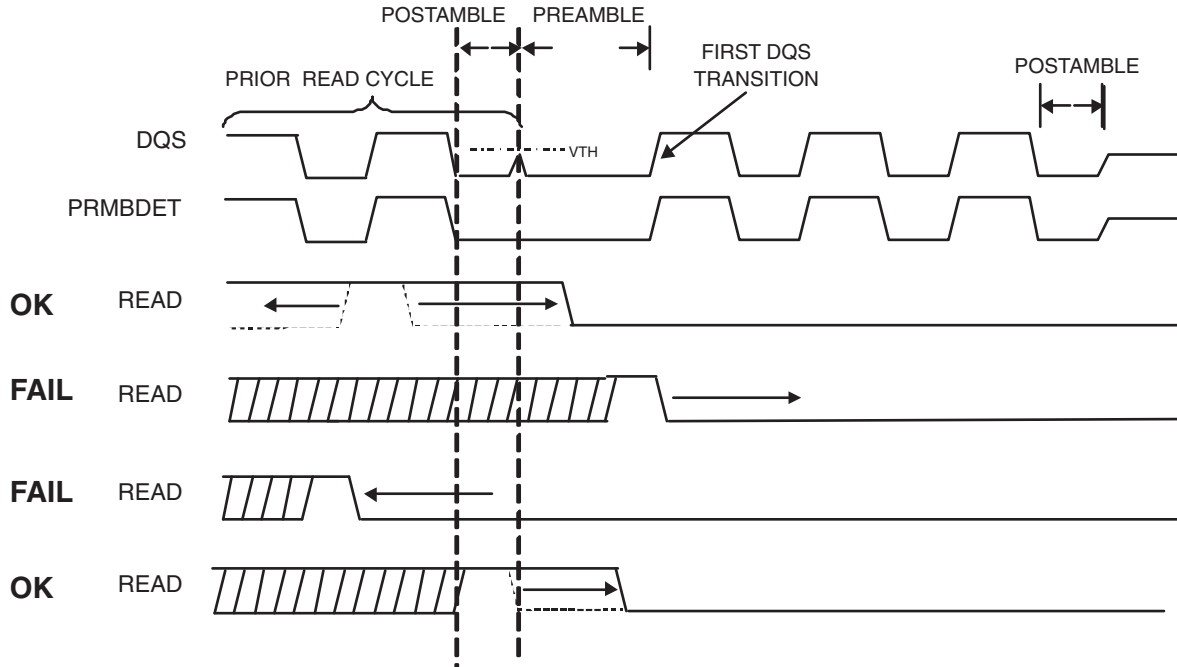
READ Pulse Generation

The READ signal to the DQSBUFC block is internally generated in the FPGA core. The READ signal goes high when the READ command to control the DDR-SDRAM is initially asserted. This precedes the DQS preamble by one cycle, yet may overlap the trailing bits of a prior read cycle. The DQS Detect circuitry of the LatticeECP2/M device requires the falling edge of the READ signal to be placed within the preamble stage.

The preamble state of the DQS can be detected using the CAS latency and the round trip delay for the signals between the FPGA and the memory device. Note that the internal FPGA core generates the READ pulse. The rise of the READ pulse should coincide with the initial READ command of the Read Burst and need to go low before the Preamble goes high.

Figure 12-9 shows a READ Pulse timing example with respect to the PRMBDET signal.

Figure 12-9. READ Pulse Generation



IDDRMX1A

This primitive will implement the input register block in memory mode. The DDR registers are designed to use edge clock routing on the I/O side and the primary clock on the FPGA side. The ECLK input is used to connect to the DQS strobe coming from the DQS delay block (DQSBUFC primitive). The SCLK input is connected to the system (FPGA) clock. DDRCLKPOL is an input from the DQS Clock Polarity tree. This signal is generated by the DQS Transition detect circuit in the hardware. The DDRCLKPOL signal is used to choose the polarity of the SCLK to the synchronization registers.

Figure 12-10. IDDRMX1A Symbol

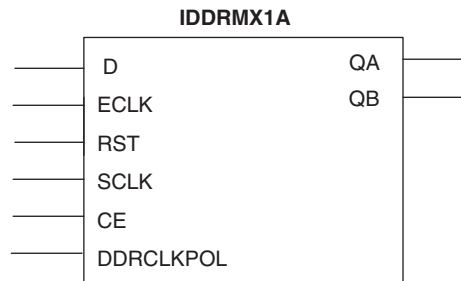


Table 12-4 provides a description of all I/O ports associated with the IDDRMX1A primitive.

Table 12-4. IDDRMX1A Ports

| Port Name | I/O | Definition |
|-----------|-----|---|
| D | I | DDR Data |
| ECLK | I | The phase shifted DQS should be connected to this input |
| RST | I | Reset |
| SCLK | I | System CLK |
| CE | I | Clock enable |
| DDRCLKPOL | I | DDR clock polarity signal |
| QA | O | Data at Positive edge of the CLK |
| QB | O | Data at the negative edge of the CLK |

Note: The DDRCLKPOL input to IDDRMX1A should be connected to the DDRCLKPOL output of DQSBUFC.

Figure 12-11 shows the Input Register Block configured in the IDDRMX1A mode.

Figure 12-11. Input Register Block in IDDRMX1A Mode

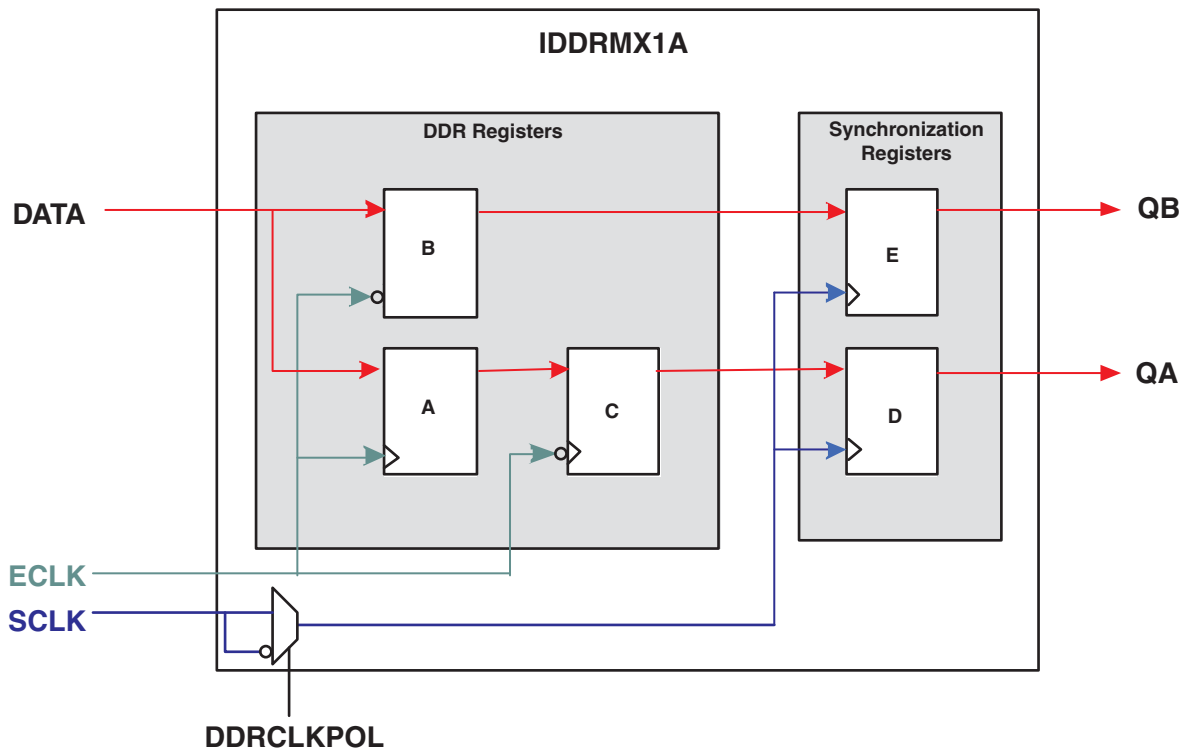


Figure 12-12 shows the IDDRMX1A timing waveform.

Figure 12-12. IDDRMX1A Waveform



IDDRMX1A

With the IDDRMX1A, the data can enter the FPGA at either the positive or negative edge of the SCLK depending on the state of the DDRCLKPOL signal. The IDDRMX1A module includes an additional clock transfer stage that ensures that the data is transferred at a known edge of the system clock.

Figure 12-13. IDDRMX1A Symbol

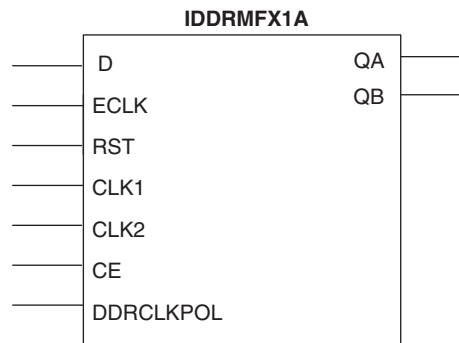


Table 12-5 provides a description of all I/O ports associated with the IDDRMX1A primitive.

Table 12-5. IDDRMFX1A Ports

| Port Name | I/O | Description |
|-----------|-----|---|
| D | I | DDR Data |
| ECLK | I | The phase shifted DQS should be connected to this input |
| RST | I | Reset |
| CLK1 | I | Slow FPGA CLK |
| CLK2 | I | Slow FPGA CLK |
| CE | I | Clock enable |
| DDRCLKPOL | I | DDR clock polarity signal |
| QA | O | Data at the positive edge of the CLK |
| QB | O | Data at the negative edge of the CLK |

Note: The DDRCLKPOL input to IDDRMFX1A should be connected to the DDRCLKPOL output of DQSBUFC.

Figure 12-14 shows the LatticeECP2 Input Register Block configured to function in the IDDRMFX1A mode.

The DDR registers are designed to use Edge clock routing on the I/O side and the primary clock on the FPGA side. The ECLK input is used to connect to the DQS strobe coming from the DQS delay block (DQSBUFC primitive). The CLK1 and CLK2 inputs should be connected to the slow system (FPGA) clock. DDRCLKPOL is an input from the DQS Clock Polarity tree. This signal is generated by the DQS Transition detect circuit in the hardware. The additional clock transfer registers are shared with the output register block.

Figure 12-14. Input Register Block in IDDRMFX1A Mode

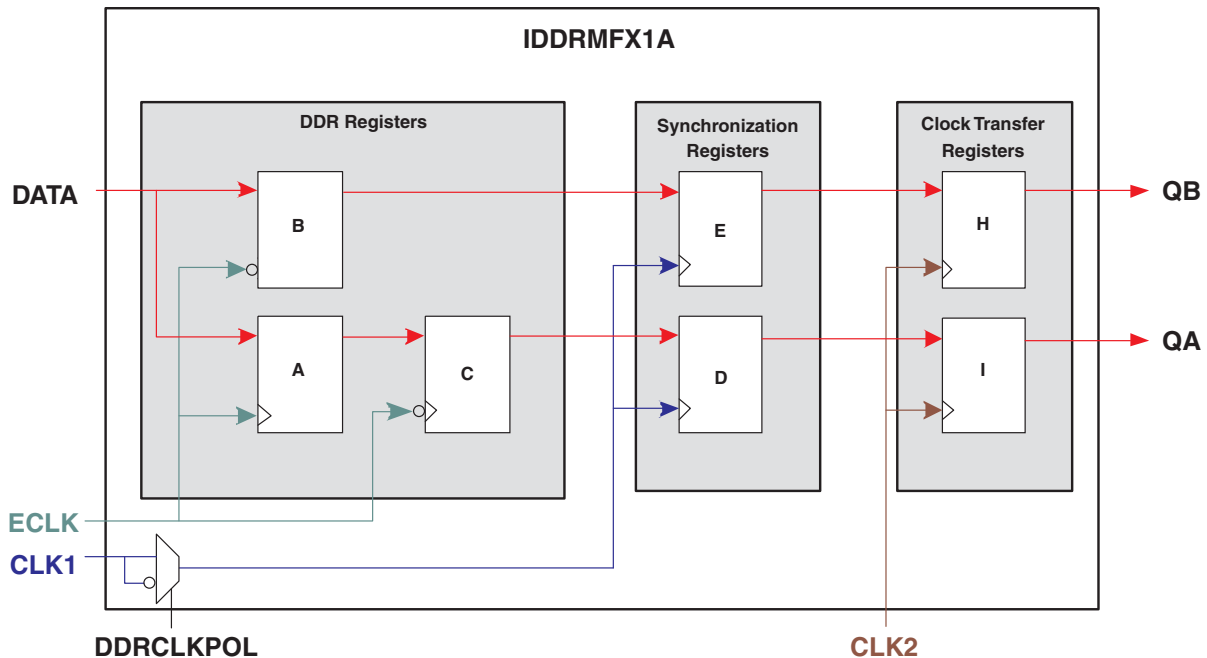
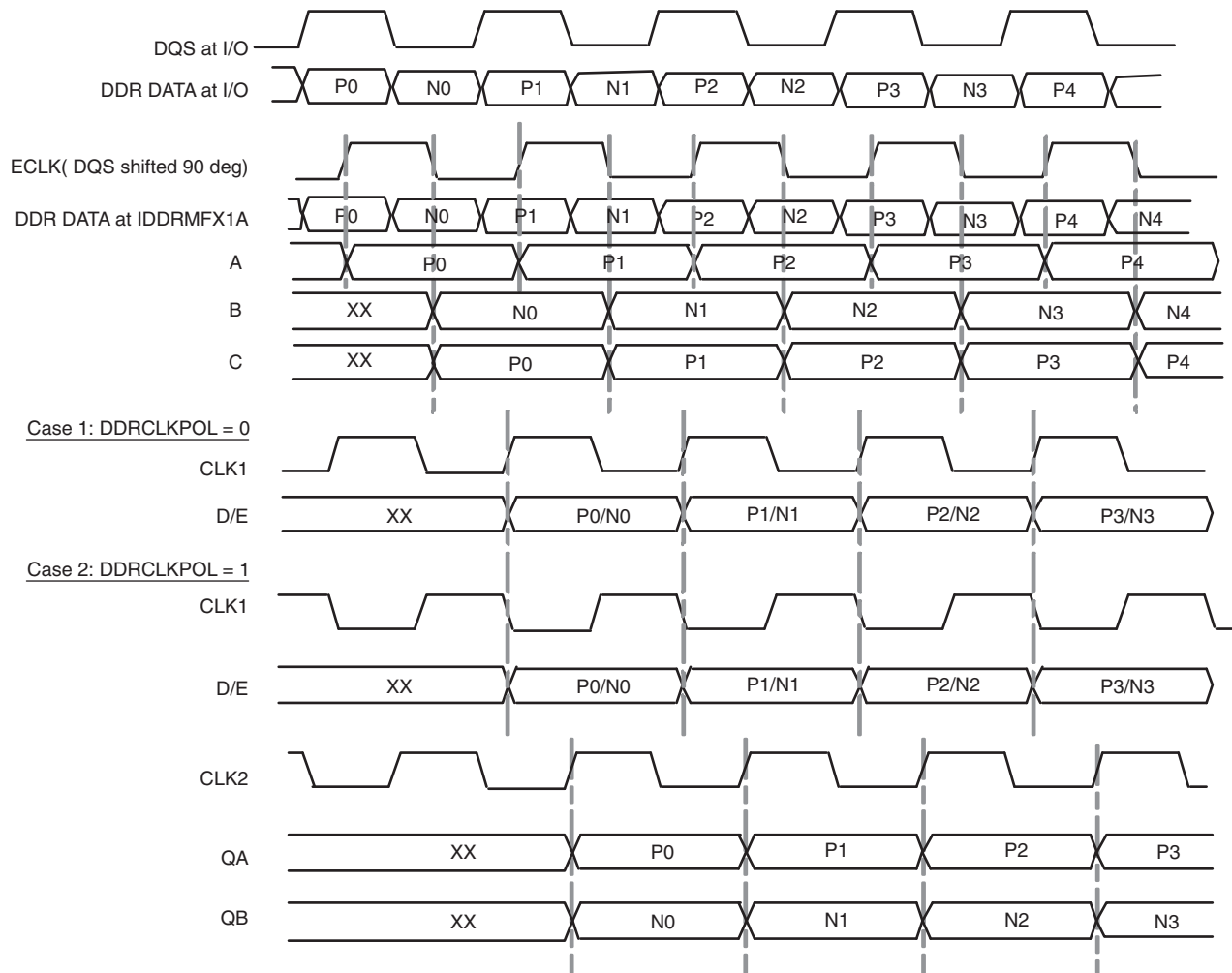


Figure 12-15 shows the IDDRMFX1A timing waveform.

Figure 12-15. IDDRMF1A Waveform



ODDRMXA

The ODDRMXA primitive implements the output register for both the write and the tristate functions. This primitive is used to output DDR data and the DQS strobe to the memory. All the DDR output tristate functions are also implemented using this primitive.

Figure 12-16 shows the ODDRMXA primitive symbol and its I/O ports.

Figure 12-16. ODDRMXA Symbol

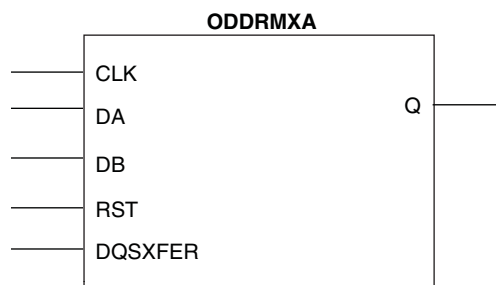


Table 12-6 provides a description of all I/O ports associated with the ODDRMXA primitive.

Table 12-6. ODDRMXA Ports

| Port Name | I/O | Description |
|-----------|-----|---|
| CLK | I | System CLK or ECLK |
| DA | I | Data at the negative edge of the clock |
| DB | I | Data at the positive edge of the clock |
| RST | I | Reset |
| DQSXFER | I | 90-degree phase shifted clock coming from the DQSBUFC block |
| Q | I | DDR data to the memory |

Notes:

1. RST should be held low during DDR Write operation.
2. DDR output and tristate registers do not have CE support. RST is available for the tristate DDRX mode (while reading). The LSR will default to set when used in the tristate mode.
3. When asserting reset during DDR writes, it is important to keep in mind that this only resets the flip-flops and not the latches.

Figure 12-17 shows the LatticeECP2 Output Register Block configured in the ODDRXMA mode.

Figure 12-17. Output Register Block in ODDRXMA Mode

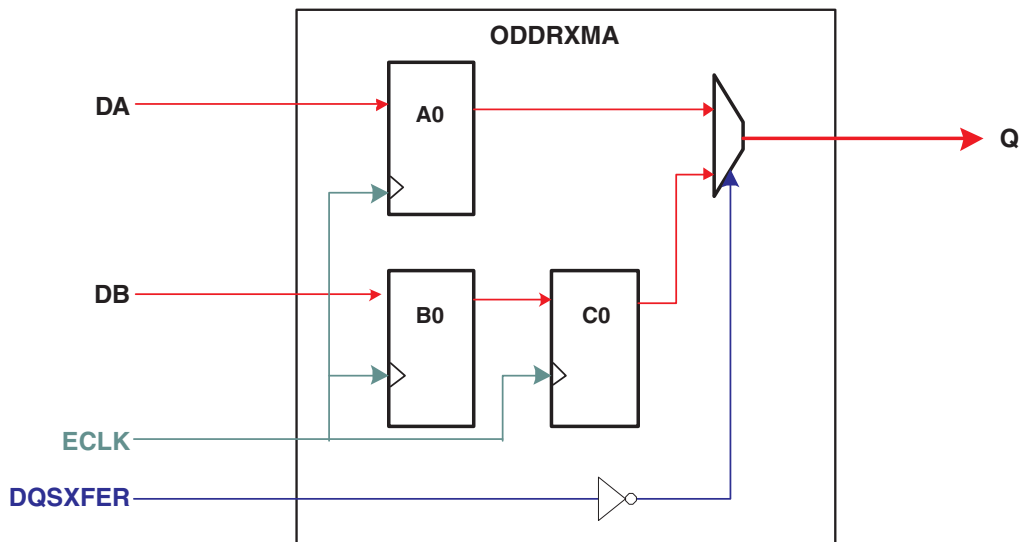
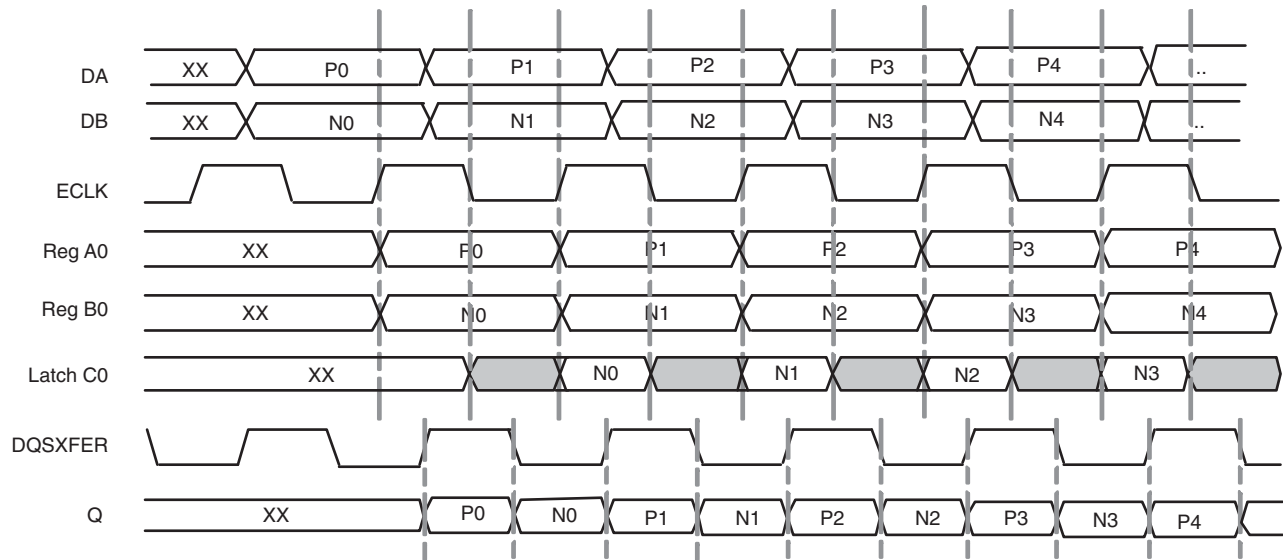


Figure 12-18 shows the ODDRMXA timing waveform.

Figure 12-18. ODDRMXA Waveform

Note that the DQSXFER is inverted inside the ODDRXMA. This will cause the data coming out of the ODDRXMA to be -90° in phase with the output of the ODDRXC module.

Memory Read Implementation

LatticeECP2/M devices contain a variety of features to simplify implementation of the read portion of a DDR interface:

- DLL compensated DQS delay elements
- DDR input registers
- Automatic DQS to system clock domain transfer circuitry
- Data Valid Module

DLL Compensated DQS Delay Elements

The DQS from the memory is connected to the DQS Delay element. The DQS Delay block receives a 6-bit delay control from the on-chip DQSDLL. This 6-bit delay is modeled as a single bit in the software. The LatticeECP2/M devices support two DQSDLL, one on the left and one on the right side of the device. The DQSDEL generated by the DQSDLL on the left side is routed to all the DQS blocks on the left and bottom half of the device. The delay generated by the DQSDLL on the right side is distributed to all the DQS Delay blocks on the right side and the other bottom half of the device. There are no DQS pins on the top banks of the device. These digital delay control signals are used to delay the DQS from the memory by 90 degrees.

The DQS received from the memory is delayed in each of the DQS Delay blocks and this delayed DQS is used to clock the first set stage DDR input registers.

DQS Transition Detect or Automatic Clock Polarity Select

In a typical DDR memory interface design, the phase relation between the incoming delayed DQS strobe and the internal system clock (during the READ cycle) is unknown. Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). Coming out of tristate, the DDR memory device drives DQS low in the Preamble State. The DQS Transition Detect block detects the first DQS rising edge after a preamble transition and generates a signal indicating the required polarity for the FPGA system clock (DDRCLKPOL). This signal is used to control the polarity of the clock to the synchronizing registers.

Data Valid Module

The data valid module generates a DATAVALID signal. This signal indicates to the FPGA that valid data is transmitted out the input DDR registers to the FPGA core.

DDR I/O Register Implementation

The first set of DDR registers is used to de-mux the DDR data at the positive and negative edge of the phase shifted DQS signal. The register that captures the positive-edge data is followed by a negative-edge triggered register. This register transfers the positive edge data from the first register to the negative edge of DQS so that both the positive and negative portions of the data are now aligned to the negative edge of DQS.

The second stage of registers is clocked by the FPGA clock, the polarity of this clock is selected by the DDR Clock Polarity signal generated by the DQS Transition Detect Block.

The I/O Logic registers can be implemented in two modes:

- Half Clock Transfer Mode
- Full Clock Transfer Mode

In Half Clock Transfer mode the data is transferred to the FPGA core after the second stage of the register. In Full Clock Transfer mode, an additional stage of I/O registers clocked by the FPGA clock is used to transfer the data to the FPGA core.

The [LatticeECP2/M Family Data Sheet](#) explains each of these circuit elements in more detail.

Memory Read Implementation in Software

Three primitives in the ispLEVER® design tools represent the capability of these three elements. The DQSDLL represents the DLL used for calibration. The IDDRMX1A/IDDRMFX1A primitive represents the DDR input registers and clock domain transfer registers with or without full clock transfer. Finally, the DQSBUFC represents the DQS delay block, the clock polarity control logic and the Data Valid module. Figures 12-19 and 12-20 show the READ interface block generated using the IPexpress™ tool in the ispLEVER software.

Figure 12-19. Software Primitive Implementation for Memory READ (Half Clock Transfer)

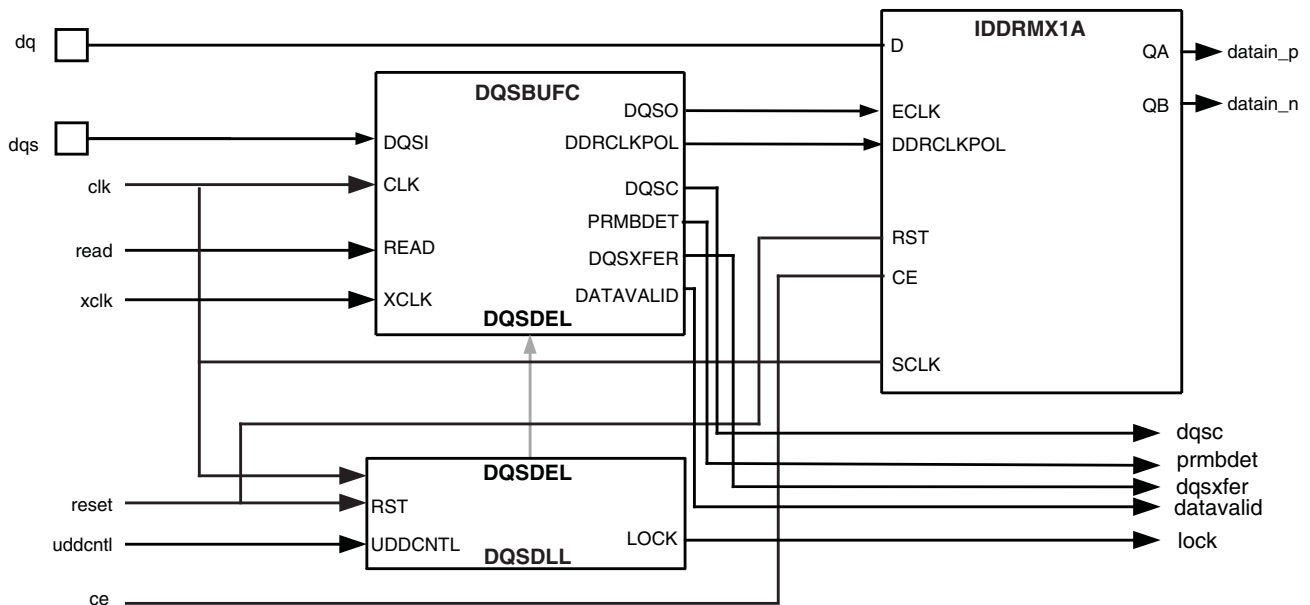
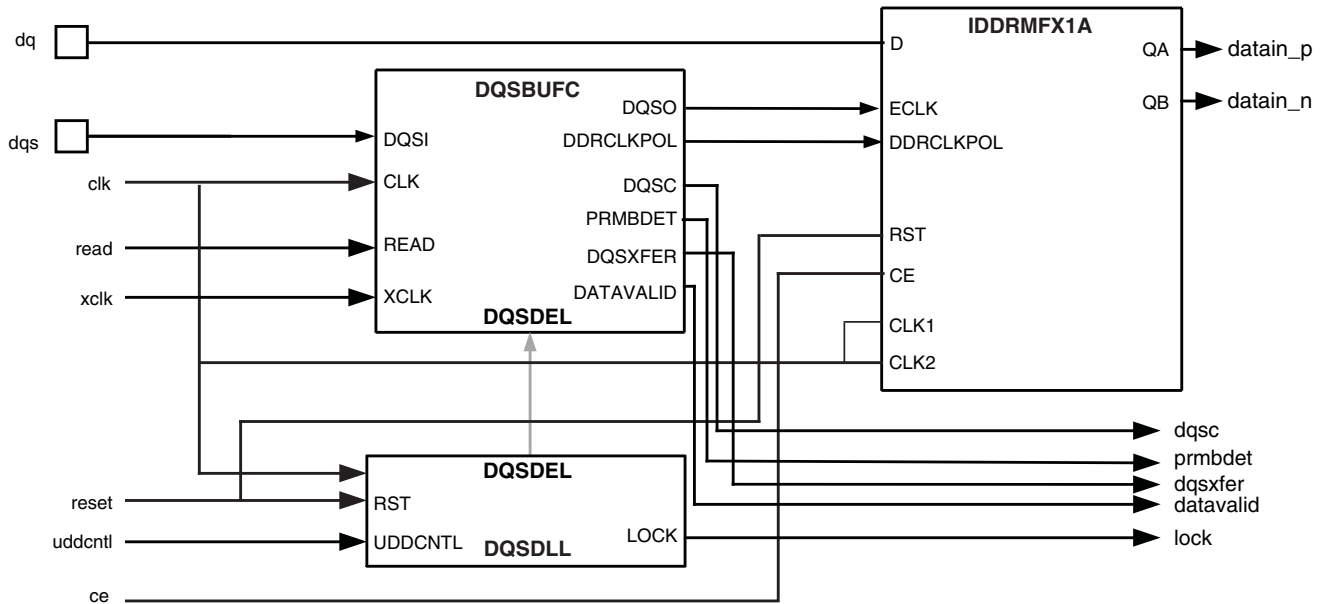


Figure 12-20. Software Primitive Implementation for Memory READ (Full Clock Transfer)



Read Timing Waveforms

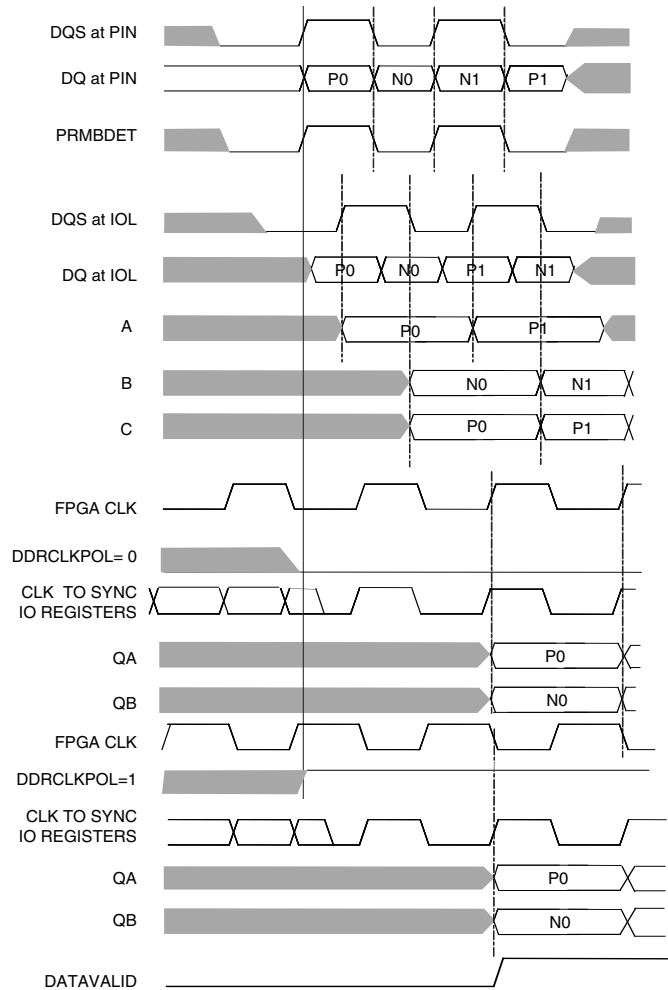
Figures 12-21 and 12-22 show READ data transfer for half and full clock cycle data transfer based on the results of the DQS Transition detector logic. This circuitry decides whether or not to invert the phase of FPGA system CLK to the synchronization registers based on the relative phases of PRMBDET and CLK.

- **Case 1:** If the FPGA clock is low on the first PRMBDET transition, then DDRCLKPOL is low and no inversion is required.
- **Case 2:** If the FPGA clock is high on the first PRMBDET, then DDRCLKPOL is high and the FPGA clock (CLK) needs to be inverted before it is used for synchronization.

Figure 12-21 illustrates the DDR data timing using half clock transfer mode at different stages of the IDDRMX1A registers. The first stage of the register captures data on the positive edge as shown by signal A and the negative edge as shown by signal B. Data stream A goes through an additional half clock cycle transfer shown by signal C. Phase-aligned data streams B and C are presented to the next stage registers clocked by the FPGA clock.

Figure 12-22 illustrates the DDR data timing using full clock transfer mode at different stages of IDDRMX1A registers. In addition to the first two register stages in the half clock mode, the full clock transfer mode has an additional stage register clocked by the FPGA clock. In this case, D and E are the data streams after the second register stage presented to the final stage of registers clocked by the FPGA clock.

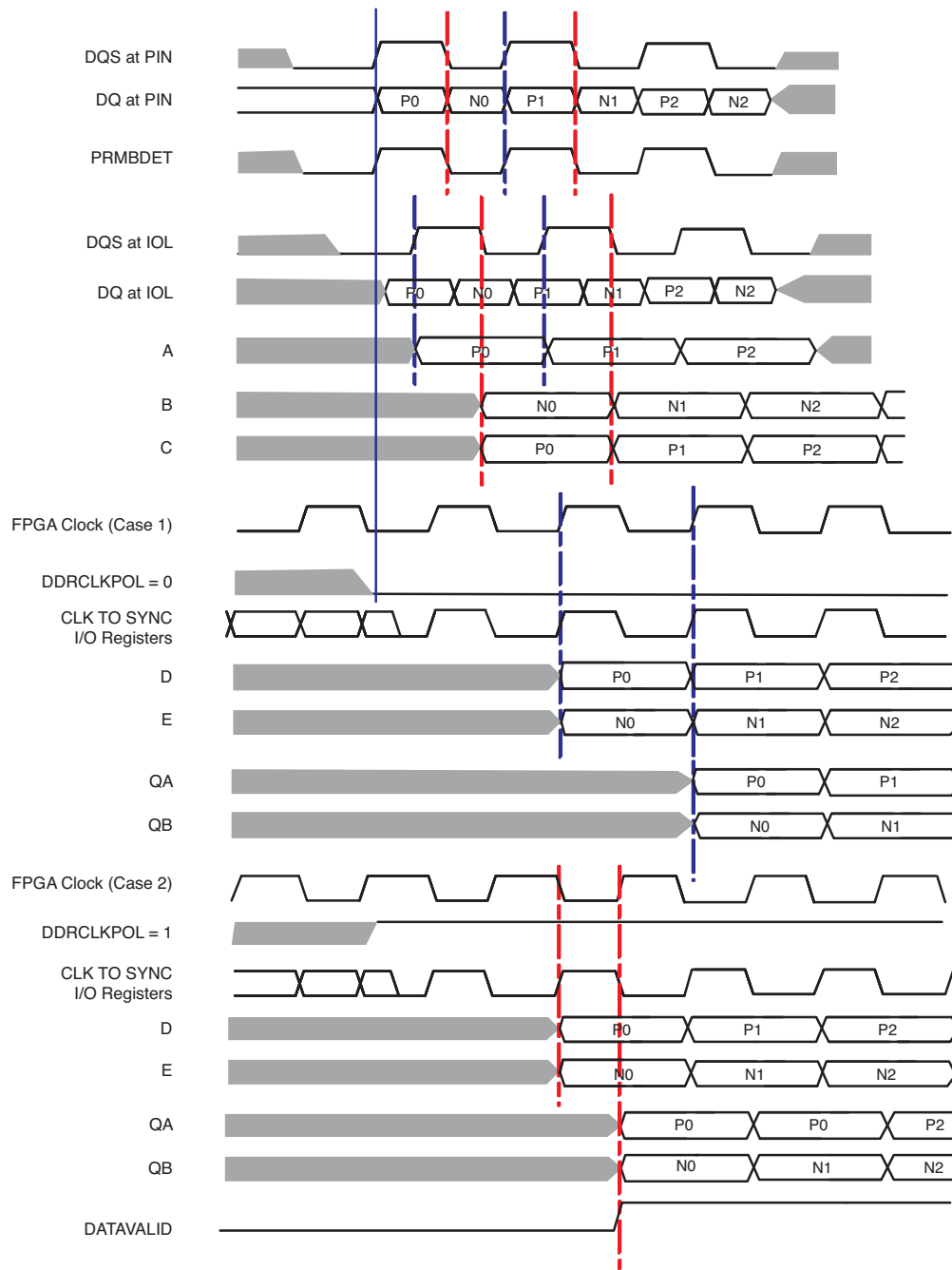
Figure 12-21. READ Data Transfer When Using IDDRMX1A



Notes:

1. DDR memory sends DQ aligned to DQS Strobe.
2. The DQS Strobe is delayed by 90 degrees using the dedicated DQS logic.
3. DQ is now center aligned to DQS Strobe.
4. PRMBDET is the Preamble detect signal generated using the DQSBUFB primitive. This is used to generate the DDRCLKPOL signal.
5. The first set of I/O registers, A and B, capture data on the positive and negative edges of DQS.
6. I/O Register C transfers data so that both data are now aligned to negative edge of DQS.
7. DDCLKPOL signal generated will determine if the FPGA CLK going into the synchronization registers need to be inverted. The DDRCLKPOL=0 when the FPGA CLK is LOW at the first rising edge of PRMBDET. The clock to the synchronization registers is not inverted. The DDRCLKPOL=1 when the FPGA CLK is HIGH at the first rising edge of PRMBDET. In this case the clock to the synchronization register is inverted.
8. The I/O synchronization registers capture data on either the rising or falling edge of the FPGA clock.
9. The DATAVALID signal goes HIGH when valid data enters the FPGA core. Once DATA VALID is asserted, it stays high until the next READ pulse.

Figure 12-22. Read Data Transfer When Using IDDRMF1A



Notes:

1. DDR memory sends DQ aligned to DQS strobe.
2. The DQS strobe is delayed by 90 degrees, using the dedicated DQS logic.
3. DQ is now center-aligned to the DQS strobe.
4. PRMBDET is the preamble detect signal generated using the DQSBUFB primitive. This is used to generate the DDRCLKPOL signal.
5. The first set of I/O registers, A and B, capture data on the positive and negative edges of DQS.
6. I/O register C transfers data such that both data are aligned to the negative edge of DQS.
7. The DDRCLKPOL signal generated will determine whether the FPGA clock going into the synchronization registers needs to be inverted. The DDRCLKPOL = 0 when the FPGA clock is LOW at the first rising edge of PRMBDET. So, the clock to the synchronization registers is not inverted. The DDRCLKPOL = 1 when the FPGA clock is HIGH at the first rising edge of PRMBDET. In this case, the clock to the synchronization register is inverted.
8. Registers D and E capture data at the FPGA clock.
9. The data again registers at the FPGA clock to ensure a full clock cycle transfer.
10. The DATAVALID signal goes HIGH when valid data enters the FPGA core. Once DATAVALID is asserted, it stays HIGH until the next READ pulse.

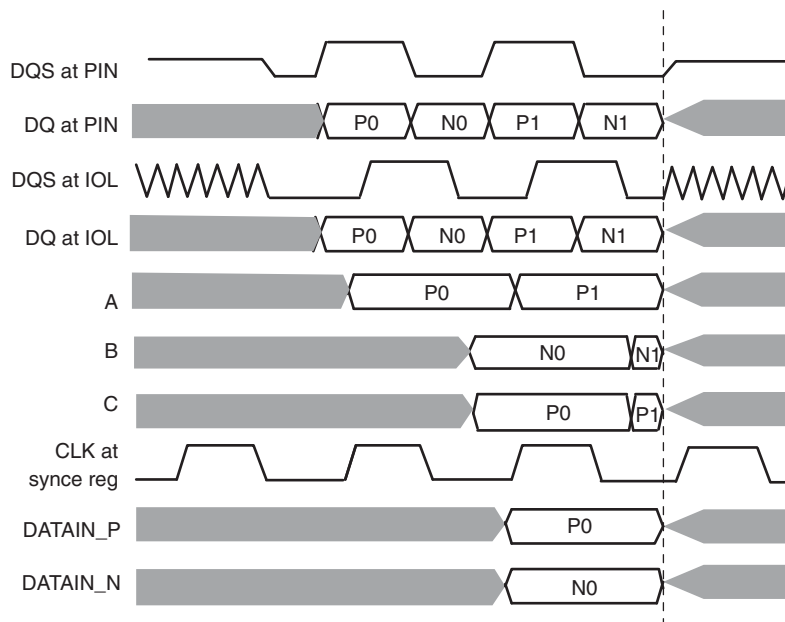
Data Read Critical Path

When using IDDRXM1A, the data in the second stage DDR registers can be registered either on the positive edge or on the falling edge of the FPGA clock depending on the DDRCLKPOL signal. In order to ensure that the data transferred to the FPGA core registers is aligned to the rising edge of the system clock, this path should be constrained with a half clock transfer. This half clock transfer can be forced in the software by assigning a multi-cycle constraint (multi-cycle of 0.5 X) on all the data paths to first PFU register. When using IDDRXMF1A, there is an additional stage of registers inside the I/O block that transfers data to the positive edge of the FPGA clock. Hence no constraint is required for this case.

DQS Postamble

At the end of a READ cycle, the DDR SDRAM device executes the READ cycle postamble and then immediately tristates both the DQ and DQS output drivers. Since neither the memory controller (FPGA) nor the DDR SDRAM device are driving DQ or DQS at that time, these signals float to a level determined by the off-chip termination resistors. While these signals are floating, noise on the DQS strobe may be interpreted as a valid strobe signal by the FPGA input buffer. This can cause the last READ data captured in the IOL input DDR registers to be overwritten before the data has been transferred to the free running resynchronization registers inside the FPGA.

Figure 12-23. Postamble Effect on READ



LatticeECP2/M devices have extra dedicated logic in the in the DQS Delay Block that prevents this postamble problem. The DQS postamble logic is automatically implemented when the user instantiates the DQS Delay logic (DQSBUFC software primitive) in the design.

Memory Write Implementation

To implement the write portion of a DDR memory interface, two streams of single data rate data must be multiplexed together with data transitioning on both edges of the clock. In addition, during a write cycle, DQS must arrive at the memory pins center-aligned with the data, DQ. Along with the DQS strobe and data this portion of the interface must also provide the CLKP, CLKN Address/Command and Data Mask (DM) signals to the memory.

It is the responsibility of the FPGA output control to edge-align the DDR output signals (ADDR,CMD, DQS, but not DQ, DM) to the rising edge of the outgoing differential clock (CLKP/CLKN).

Challenges encountered by the during Memory WRITE:

1. DQS needs to be center-aligned with the outgoing DDR Data, DQ.

2. Differential CLK signals (CLKP and CLKN) need to be generated.
3. The controller must meet the DDR interface specification for t_{DSS} and t_{DSH} parameters, defined as DQS falling to CLKP rising setup and hold times.
4. The DDR output data must be muxed from two SDR streams into a single outgoing DDR data stream.

All DDR output signals (“ADDR, CMD”, DQS, DQ, DM) are initially aligned to the rising edge of the FPGA clock inside the FPGA core. The relative phase of the signals may be adjusted in the IOL logic before departing the FPGA. These adjustments are shown in Figure 12-24.

LatticeECP2/M devices contain DDR output and tri-state registers along with the DQSXFER signal generated by the DQSBUFC that allows easy implementation of the write portion of the DDR memory interfaces. The DDR output registers can be accessed in the design tools via the ODDRMXA and the ODDRXC primitives.

The DQS signal and the DDR clock outputs are generated using the ODDRXC primitive. As shown in the figure, the CLKP and DQS signals are generated so that they are 180 degrees in phase with the clock. This is done by connecting “1” to the DA input and “0” to the DB inputs of the ODDRXC primitive. Refer to the DDR Generic Software Primitive section of this document to see the ODDRXC timing waveforms.

The DDR clock output is then fed into a SSTL differential output buffer to generate CLKP and CLKN differential clocks. Generating the CLKN in this manner prevents any skew between the two signals. When interfacing to DDR1, SDRAM memory CLKP should be connected to the SSTL25D I/O standard. When interfacing to DDR2 memory, it should be connected to the SSTL18D I/O standard.

The DQSXFER output from the DQSBUFC block is the 90-degree phase shifted clock. This 90-degree phase shifted clock is used as an input to the ODDRMXA block. The ODDRMXA is used to generate the DQ and DM data outputs going to the memory. In the ODDRMXA module, the data is first registered using the ECLK or FPGA clock input and then shifted out using the DQSXFER signal. To ensure that the data going to the memory is center-aligned to the DQS, the DQSXFER is inverted inside the ODDRMXA primitive. This will generate data that is center-aligned to the DQS. Refer to the Software Primitives section of this document for the ODDRMXA timing waveforms.

The DDR interface specification for t_{DSS} and t_{DSH} parameters defined as DQS falling to CLKP rising setup and hold times must be met. This is accomplished by ensuring that the CLKP and DQS signals are identical in phase.

The tristate control for the DQS and DQ outputs can also be implemented using the ODDRXC primitive.

Figure 12-24 shows the DDR Write implementation using the DDR primitives.

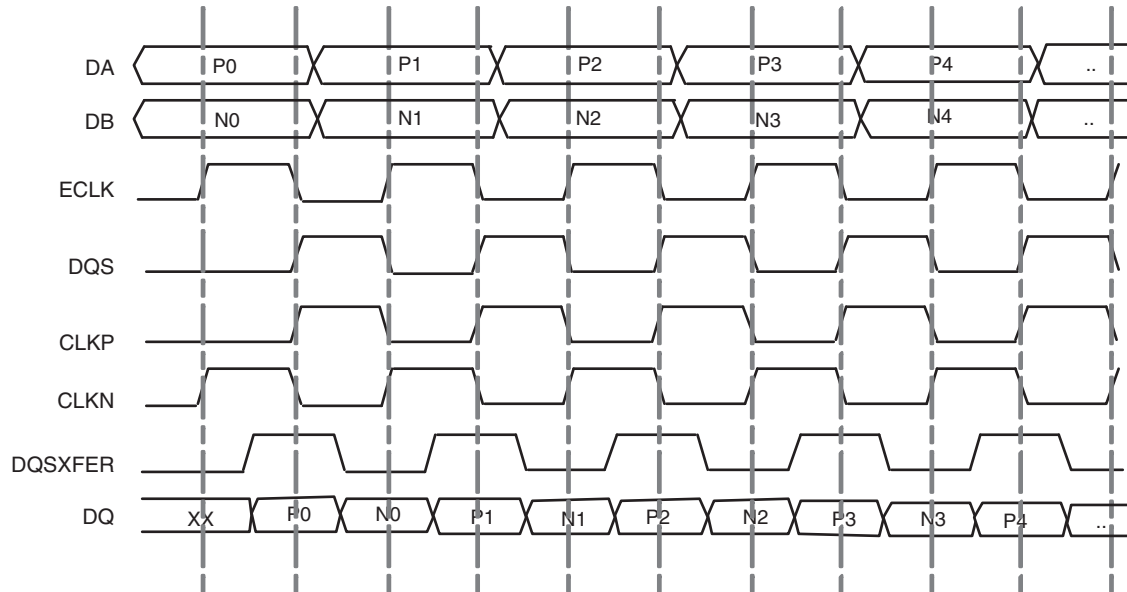
Figure 12-24. Software Implementation for Memory Write



Write Timing Waveforms

Figure 12-25 shows the DDR write side data transfer timing for the DQ Data pad and the DQS Strobe Pad. When writing to the DDR memory device, the DM (Data Mask) and the ADDR/ CMD (Address and Command) signals are also sent to the memory device along with the data and strobe signals.

Figure 12-25. DDR Write Data Transfer for DQ Data

**Design Rules/Guidelines**

Listed below are some rules and guidelines to keep in mind when implementing DDR memory interfaces in the LatticeECP2/M devices.

- The LatticeECP2/M devices have dedicated DQ-DQS banks. Please refer to the logical signal connections of the groups in the [LatticeECP2/M Family Data Sheet](#) before locking these pins.
- There are two DQSDLL on the device, one for the left half and one for the right half of the device. Therefore, only one DQSDLL primitive should be instantiated for each half of the device. Since there is only one DQSDLL on each half of the device, all the DDR memory interfaces on that half of the device should run at the same frequency. Each of the DQSDLL will generate 90-degree digital delay bits for all the DQS delay blocks on that half of the device based on the reference clock input to the DLL.
- When implementing a DDR SDRAM interface, all interface signals should be connected to the SSTL25 I/O standard. In the case of the DDR2 SDRAM interface, the interface signal should be connected to SSTL18 I/O standard.
- For DDR2, the differential DQS signals need to be connected to SSTL18 the Differential I/O standard.
- When implementing the DDR interface, the VREF1 of the bank is used to provide the reference voltage for the interface pins.

Generic High Speed DDR Implementation

In addition to the DDR memory interface, the I/O logic DDR registers can be used to implement high speed DDR interfaces. The Input DDR registers can operate in full clock transfer and half clock transfer modes. The DDR input and output register also support x1 and x2 gearing ratios. A gearing capability is provided to Mux/DeMux the I/O data rate (ECLK) to the FPGA clock rate (SCLK). For DDR interfaces, this ratio is slightly different than the SDR ratio. A basic 2x DDR element provides four FPGA side bits for two I/O side bits at half the clock rate on the FPGA side.

The data going to the DDR registers can be optionally delayed before going to the DDR register block.

Generic DDR Software Primitives

The IPexpress tool in the ispLEVER software can be used to generate the DDR modules. The various DDR modes described below can be configured in the IPexpress tool. The various modes are implemented using the following software primitives.

- IDDRXC – DDR Generic Input
- IDDRFXA – DDR Generic Input with full clock transfer (x1 gearbox)
- IDDRX2B – DDR Generic Input with 2x gearing ratio. DDRX2 inputs a double data rate signal as four data streams. Two stages of DDR registers are used to convert serial DDR data at input pad into four SDR data streams entering FPGA core logic.
- ODDRXC – DDR Generic Output
- ODDRX2B – DDR Generic Output with 2x gearing ratio. The DDRX2 inputs four separate data streams and outputs a single data stream to the I/O buffer.
- DELAYB – The DDR input can be optionally delayed before it is input to the DDR registers. The user can choose to implement a fixed delay value or use a dynamic delay.

IDDRXC

This primitive inputs DDR data at both edges of the CLK and generates two streams of data. The CLK to this module can be connected to either the edge clock or the primary FPGA clock.

Figure 12-26 shows the primitive symbol for IDDRXC mode.

Figure 12-26. IDDRXC Symbol

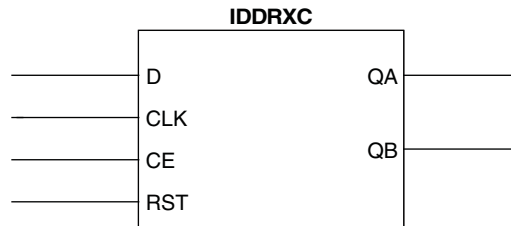


Table 12-7 lists the port names and descriptions for the IDDRXC primitive.

Table 12-7. IDDRXC Port Names

| Port Name | I/O | Definition |
|-----------|-----|---|
| D | I | DDR data |
| CLK | I | This clock can be connected to the ECLK or the FPGA clock |
| CE | I | Clock enable signal |
| RST | I | Reset to the DDR register |
| QA | O | Data at the positive edge of the clock |
| QB | O | Data at the negative edge of the clock |

Figure 12-27 shows the LatticeECP2 Input Register Block configured in the IDDRXFC mode.

Figure 12-27. Input Register Block Configured as IDDRXC

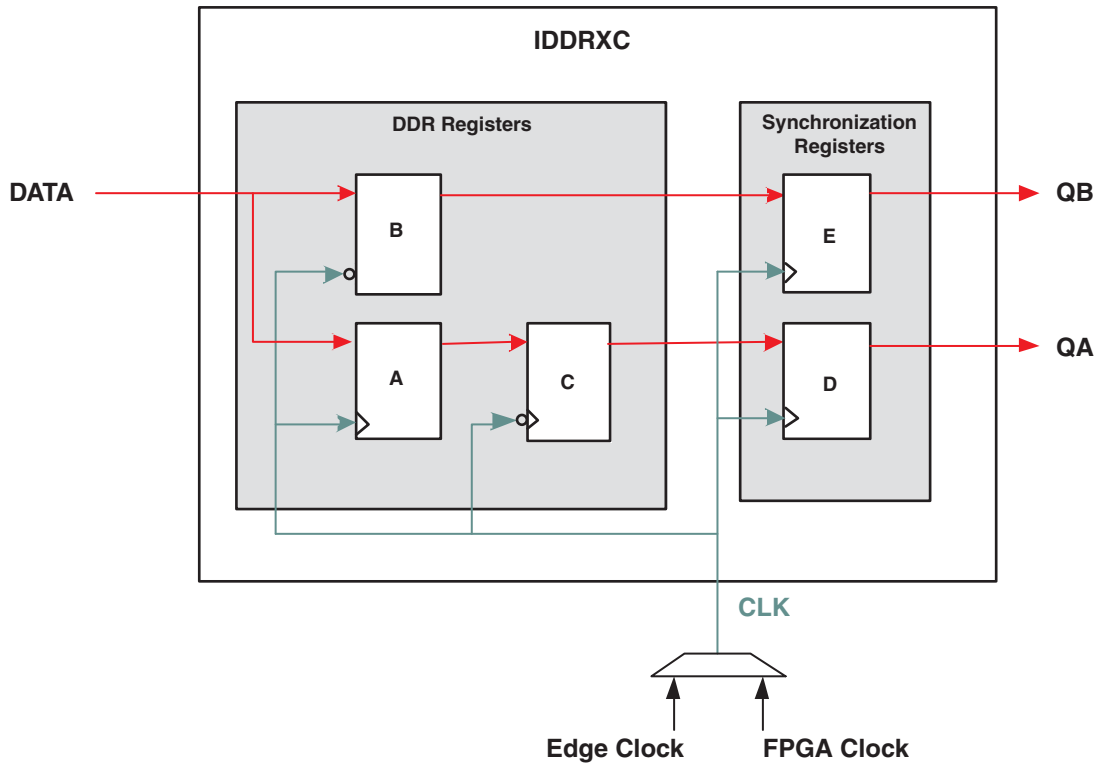
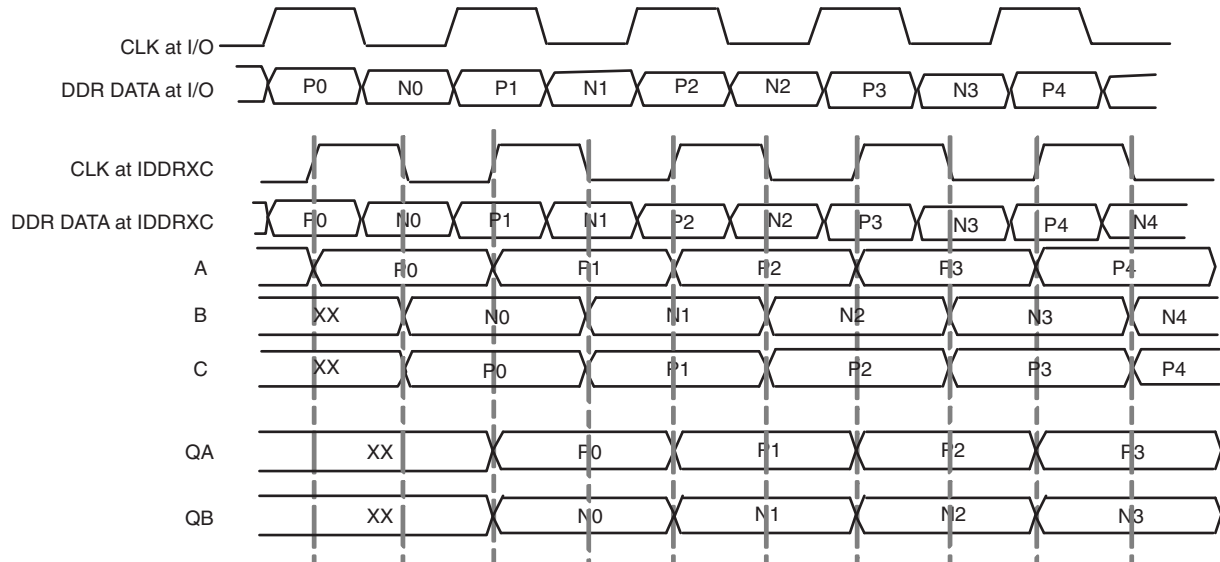


Figure 12-28 shows the timing waveform when using the IDDRXC module.

Figure 12-28. IDDRXC Waveform



IDDRFXA

This primitive inputs DDR data at both edges of clock CLK1 and generates two streams of data aligned to clock CLK2. CLK1 can be connected either to the edge clock or the internal FPGA clock. If the Edge clock input is used for CLK1 then CLK2 should be generated from the same clock going to CLK1.

Figure 12-29 shows the primitive symbol for the IDDRFXA mode.

Figure 12-29. IDDRFXA Symbol

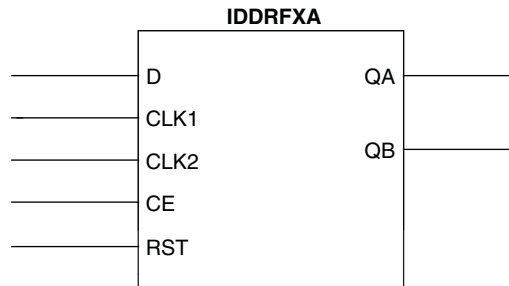


Table 12-8 lists the port names and descriptions for the IDDRFXA primitive.

Table 12-8. IDDRFXA Port Names

| Port Name | I/O | Description |
|-----------|-----|---|
| D | I | DDR data |
| CLK1 | I | This clock can be connected to the ECLK or the FPGA clock |
| CLK2 | I | This clock should be connected to the FPGA clock |
| CE | I | Clock Enable signal |
| RST | I | Reset to the DDR register |
| QA | O | Data at the positive edge of the clock |
| QB | O | Data at the negative edge of the clock |

Figure 12-31 shows the LatticeECP2 Input Register Block configured in the IDDRXFXA mode. CLK1 used to register the DDR registers and the first set of synchronization registers. CLK2 is used by the third stage of registers and should be clocked by the FPGA clock. These clock transfer registers are shared with the output register block.

Figure 12-30. Input Register Block configured as IDDRFXA

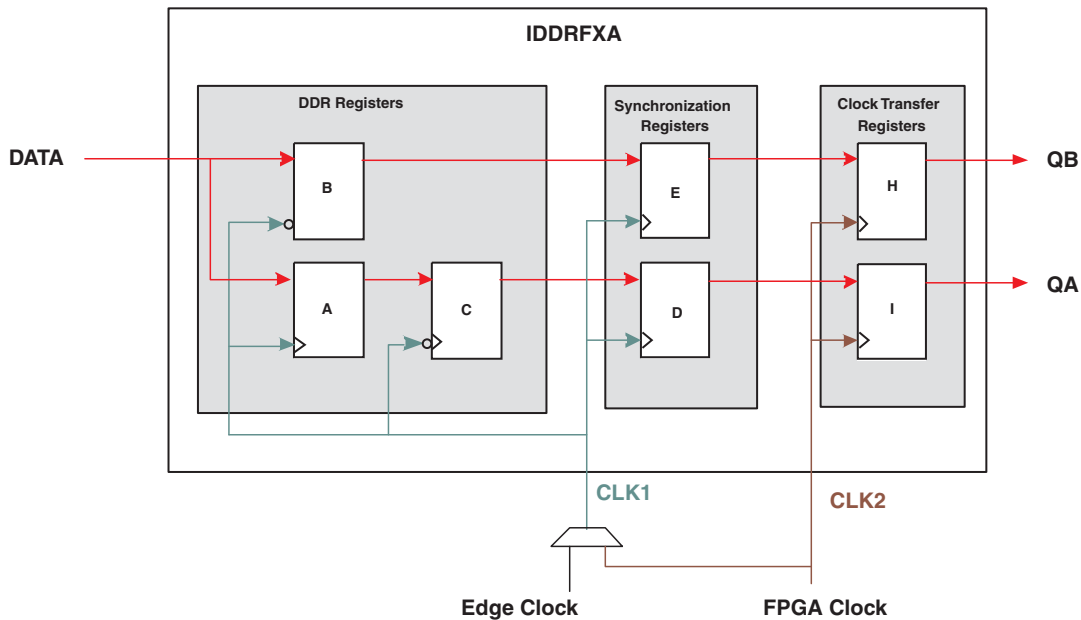
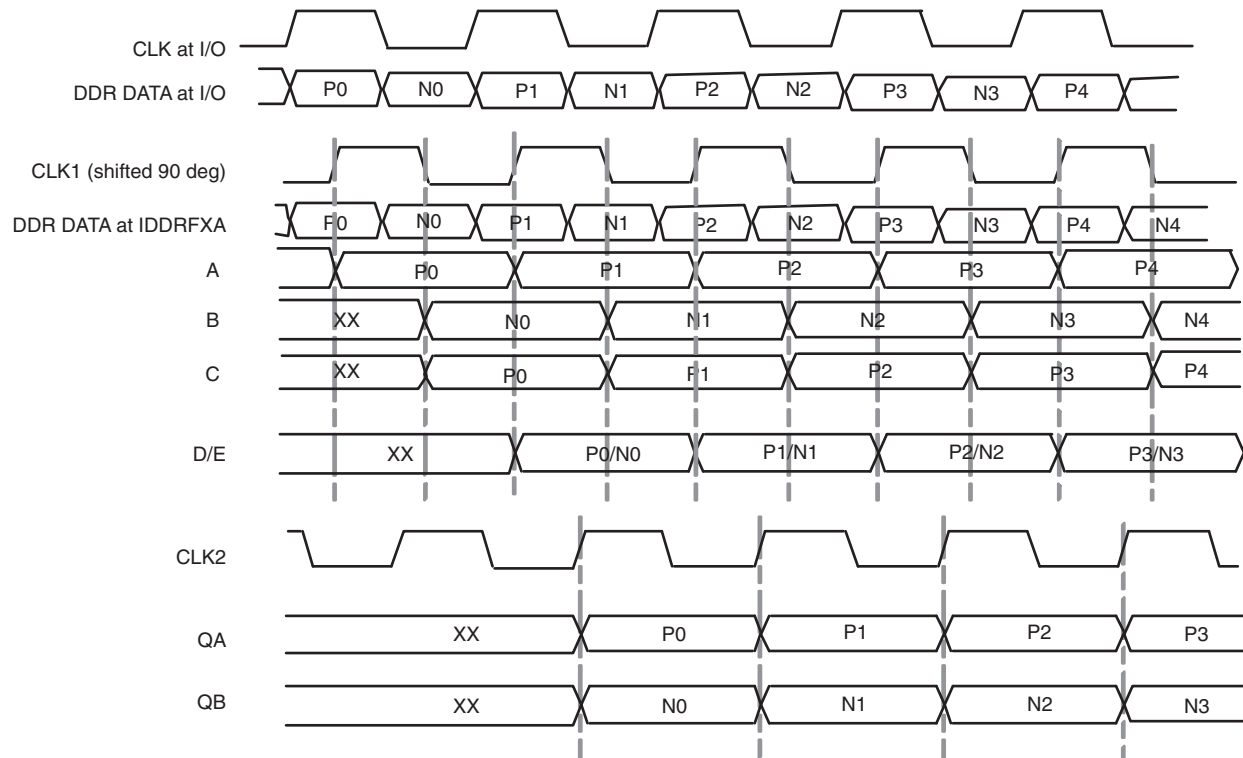


Figure 12-31 shows the timing waveform when using the IDDRFXA module.

Figure 12-31. IDDRFXA Waveform



IDDRX2B

This module is used when a gearing function is required. This primitive inputs the DDR data at both edges of the edge clock and generates four streams of data aligned to SCLK. SCLK is always half the frequency of ECLK. It is recommended that the CLKDIV module or PLL be used to generate the SCLK from the ECLK.

Figure 12-32 shows the primitive symbol for the IDDRX2B mode.

Figure 12-32. IDDRX2B Symbol

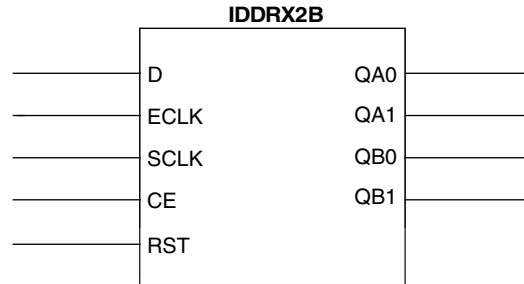


Table 12-9 lists the port names and descriptions for the IDDRX2B primitive.

Table 12-9. IDDRX2B Port Names

| Port Name | I/O | Description |
|-----------|-----|--|
| D | I | DDR data |
| ECLK | I | This clock can be connected to the fast edge clock |
| SCLK | I | This clock should be connected to the FPGA clock |
| CE | I | Clock enable signal |
| RST | I | Reset to the DDR register |
| QA0, QA1 | O | Data at the positive edge of the clock |
| QB0, QB1 | O | Data at the negative edge of the clock |

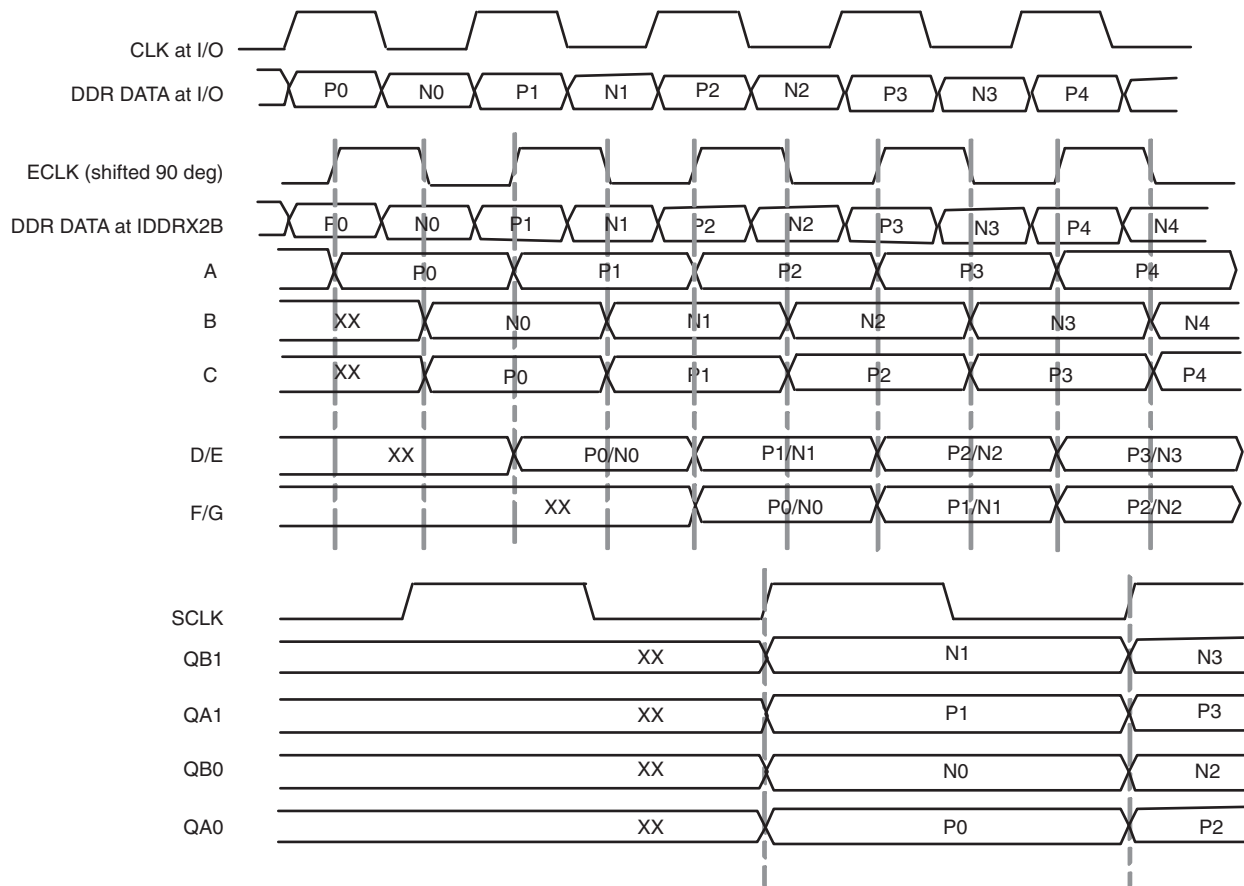
Figure 12-33 shows the LatticeECP2 Input Register Block configured in the IDDRX2B mode. The DDR registers and the first set of synchronization registers are clocked by the ECLK input. The SCLK is used to clock the third stage of register. This primitive will output four streams of data. The 2x gearing function is implemented by using the synchronization registers of the complementary PIO. The clock transfer registers are shared with the output register block.

Figure 12-33. Input Register Block Configured as IDDRX2B



Figure 12-34 shows the timing waveform using the IDDRX2B module.

Figure 12-34. IDDRX2B Waveform



ODDRXC

This is the DDR output module. This primitive will input two data streams and mux them together to generate a single stream of data going to the sysIO™ buffer. The CLK to this module can be connected to the edge clock or to the FPGA clock. This primitive is also used for when DDR function is required for the tristate signal.

Figure 12-35 shows the primitive symbol for the ODDRXC mode.

Figure 12-35. ODDRXC Symbol

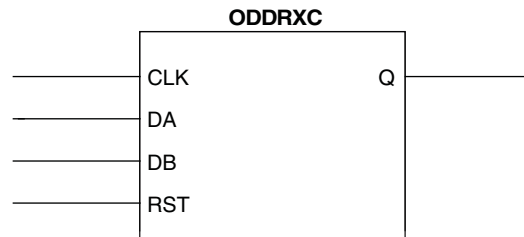


Table 12-10 lists the port names and descriptions for the ODDRXC primitive.

Table 12-10. ODDRXC Port Names

| Port Name | I/O | Definition |
|-----------|-----|--|
| DA | I | Data at the negative edge of the clock |
| DB | I | Data at the positive edge of the clock |
| CLK | I | This clock can be connected to the edge clock or to the FPGA clock |
| RST | I | Reset signal |
| Q | O | DDR data output |

Figure 12-36 shows the Output Register Block of the LatticeECP2 device configured in ODDRXC mode.

Figure 12-36. Output Register Block in ODDRC Mode



Figure 12-37 shows the timing waveform when using the ODDRXC module.

Figure 12-37. ODDRXC Waveform



ODDRX2B

This DDR output module can be used when a gearbox function is required. This primitive inputs four data streams and muxes them together to generate a single stream of data going to the sysIO buffer.

DDR registers of the complementary PIO are used in this mode. The complementary PIO register can no longer be used to perform the DDR function. There are two clocks going to this primitive. The ECLK is connected to the faster edge clock and the SCLK is connected to the slower FPGA clock. The DDR data output of this primitive is aligned to the faster edge clock.

Figure 12-38 shows the primitive symbol for the ODDRX2B mode.

Figure 12-38. ODDRX2B Symbol

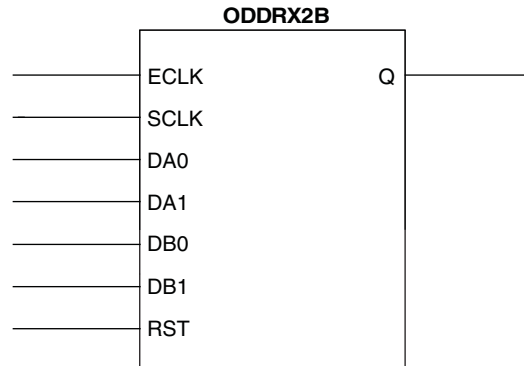


Table 12-11 lists the port names and descriptions for the ODDRX2B primitive.

Table 12-11. ODDRX2B Port Names

| Port Name | I/O | Description |
|-----------|-----|---|
| DA0, DB0 | I | Data at the negative edge of the clock |
| DA1, DB1 | I | Data at the positive edge of the clock |
| ECLK | I | This clock should be connected to the faster edge clock |
| SCLK | I | This clock should be connected to the slower FPGA clock |
| RST | I | Reset signal |
| Q | O | DDR data output |

Figure 12-39 shows the LatticeECP2 Output Register Block in the ODDRX2B mode.

Figure 12-39. Output Register Block Configured in ODDR2B Mode

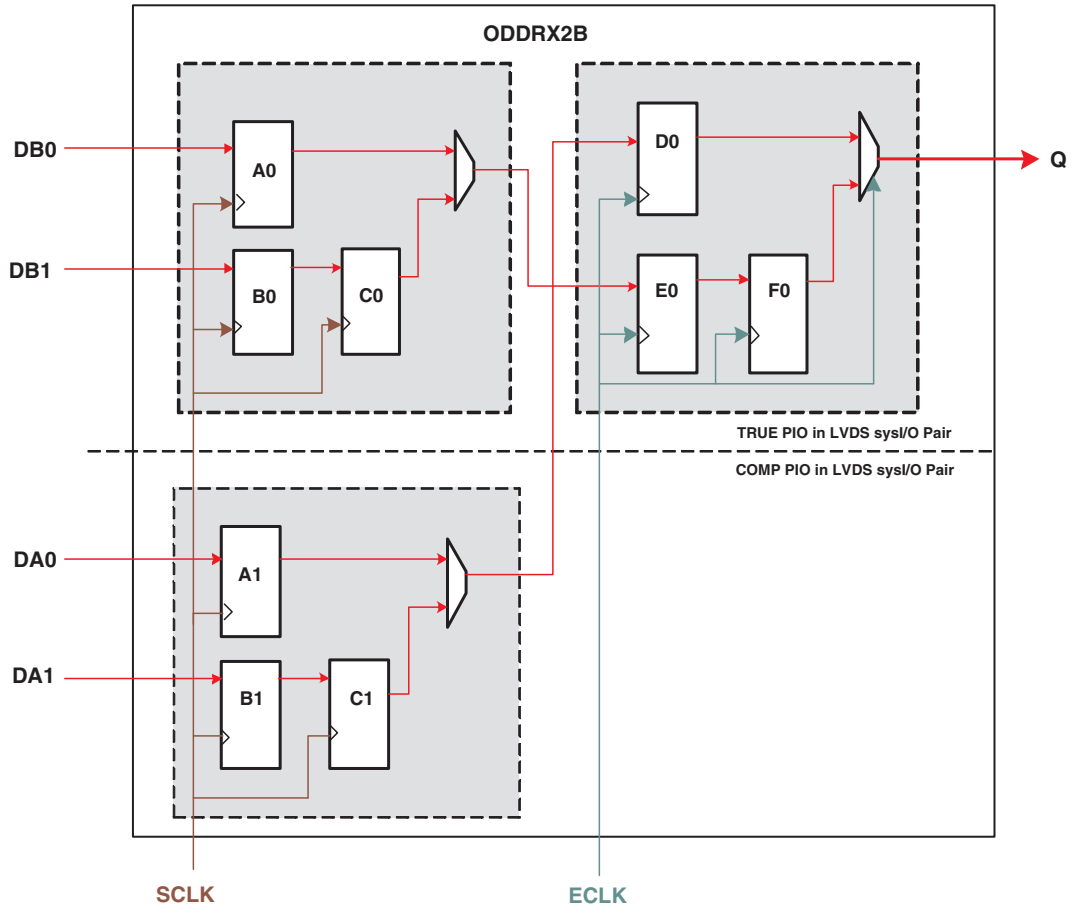
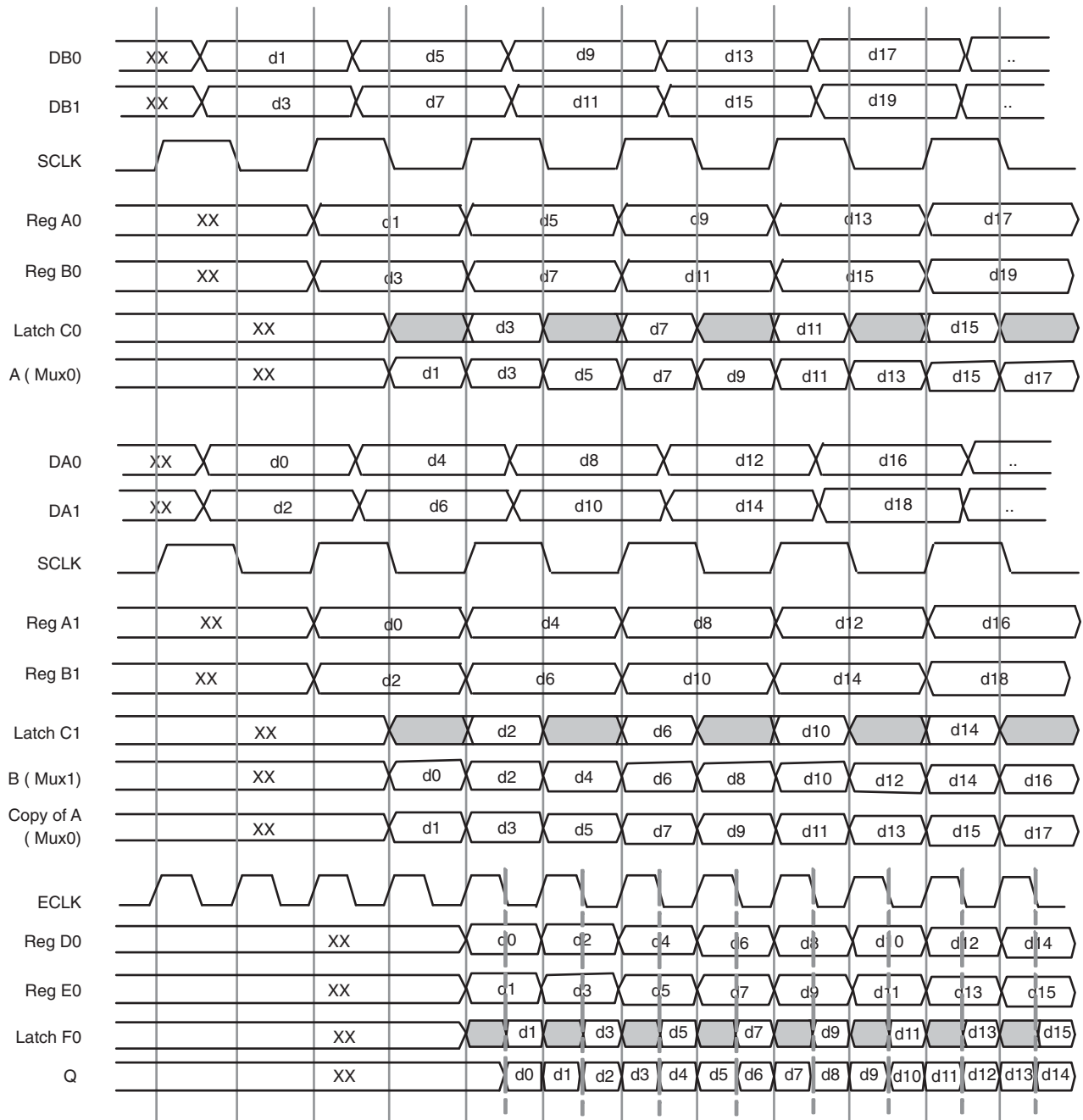


Figure 12-40 shows the timing waveform when using the ODDRXC module.

Figure 12-40. ODDRX2B Waveform



DELAYB

Data going to the DDR registers can be optionally delayed using the Delay block. The Delay block receives 4-bit delay control. The 4-bit delay can be set using fixed multiplier values or it can be controlled by the user. The DELAYB block is available for use with the input DDR registers.

The DELAYB block can be configured when generating the DDR input modules in the IPexpress tool of the software. The delay can be adjusted in 35ps steps. Users can choose from three types of delay values:

1. Dynamic – The delay value is controlled by the user logic using the DEL[3:0] input of the DELAYB block.

2. Fixed – When choosing the fixed value, the user will also need to choose from one of the 16 multiplier values. This will tie the inputs DEL[3:0] of the DELAYB block to a fixed value depending on the multiplier value chosen.
3. FIXED_XGMII – The DEL [3:0] will be configured with the delay value required when implementing a XGMII interface.

Figure 12-41 shows the primitive symbol for the DELAYB mode.

Figure 12-41. DELAYB Symbol

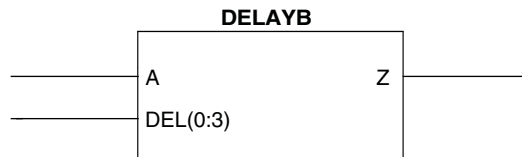


Table 12-12 lists the port names and descriptions for the DELAYB primitive.

Table 12-12. DELAYB Port Names

| Port Name | I/O | Definition |
|-----------|-----|---------------------------------|
| A | I | DDR input from the sysIO buffer |
| DEL (0:3) | I | Delay inputs |
| Z | O | Delay DDR data |

Design Rules/Guidelines

Listed below are some rules and guidelines for implementing generic DDR interfaces in LatticeECP2/M devices.

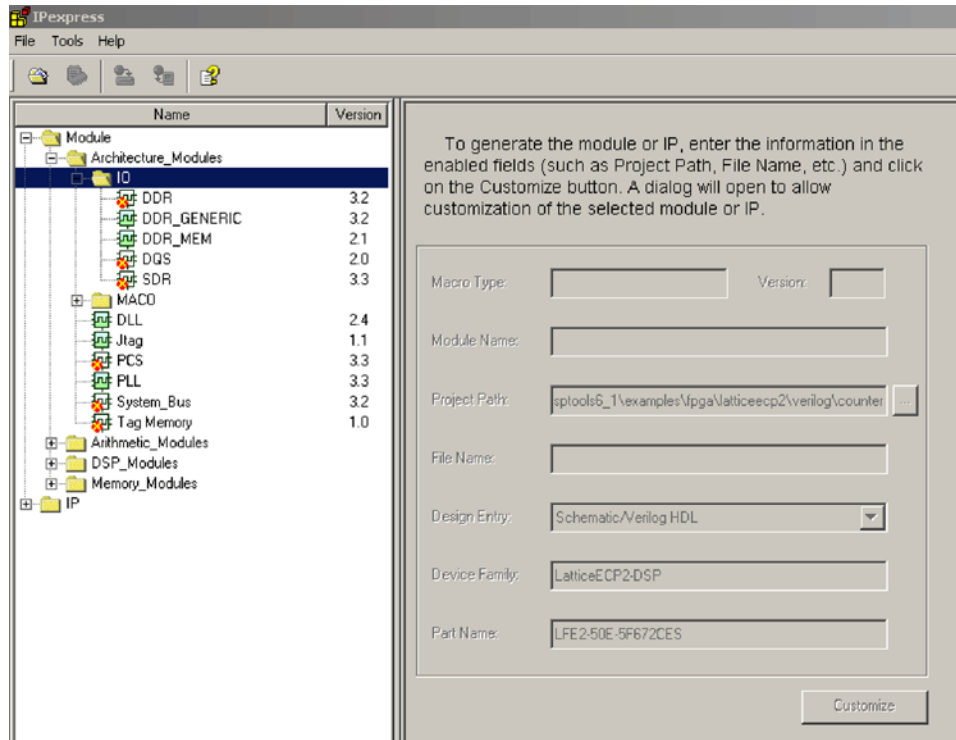
- When implementing a 2x gearing mode, the complement PIO registers are used. This complementary PIO register can no longer be used and should not be connected.
- DDR registers are available on the Left, Right and Bottom sides of the device. The top side does not support DDR registers.

DDR Usage in ispLEVER IPexpress

This section describes how IPexpress in ispLEVER is used to generate the DDR modules. If you are using Lattice Diamond™ design software, refer to Appendix A to see how DDR modules are generated in Diamond. IPexpress can be used to configure and generate the DDR Memory Interface and Generic DDR Module. The tool will generate an HDL module that will contain the DDR primitives. This module can be using in the top level design.

Figure 12-42 shows the main window of IPexpress. The DDR_Generic and DDR_MEM options under **Architecture->IO** are used to configure the DDR modules.

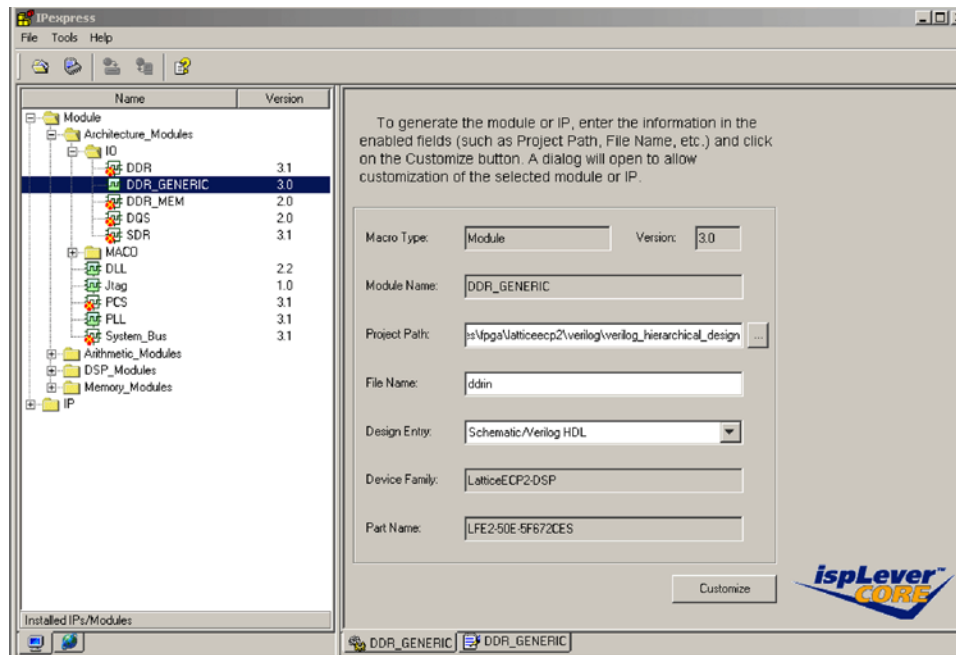
Figure 12-42. IPexpress Main Window



DDR Generic

Figure 12-43 shows the main window when DDR_Generic is selected. The only entry required in this window is the module name. Other entries are set to the project settings. The user may change these entries if desired. After entering the module name, click on **Customize** to open the **Configuration Tab** window as shown in Figure 12-44.

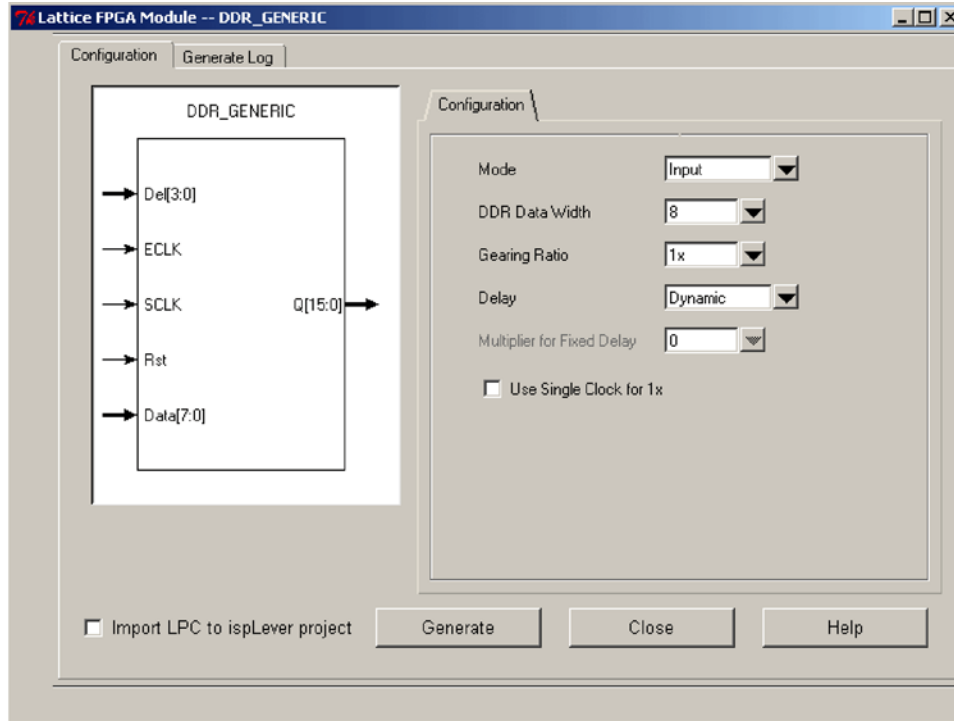
Figure 12-43. IPexpress Main Window for DDR_Generic



Configuration Tab

The Configuration Tab lists all user-accessible attributes with default values set. Upon completion, click **Generate** to generate source and constraint files. The user may choose to use the .lpc file to load parameters.

Figure 12-44. Configuration Tab for DDR_Generic



The user can change the Mode parameter to choose either Input, Output, Bidirection or Tristate DDR module. The other configuration parameters will change according to the mode selected. The Delay parameter is only available for Input and Bidirectional modes. Similarly the Multiplier for Fixed Delay parameter is only available when the Delay parameter is configured to Fixed.

Table 12-13. User Parameters in the IPexpress GUI

| User Parameters | Description | Values/Range | Default |
|----------------------------|--|--|---------|
| Mode | Mode selection for the DDR block. | Input, Output, Bidirectional, Tristate | Input |
| Data Width | Width of the data bus. | 1-64 | 8 |
| Gearing Ratio | Gearing ratio selection. | 1x, 2x ¹ | 1x |
| Delay | Input delay configuration. | Dynamic, Fixed, Fixed XGMII | Dynamic |
| Multiplier for Fixed Delay | Fixed delay setting. Available only when delay is configured as Fixed. | 0-15 | 0 |
| Use Single Clk for 1x | Allows the selection of a single clock for the gearing logic. | On/Off | Off |

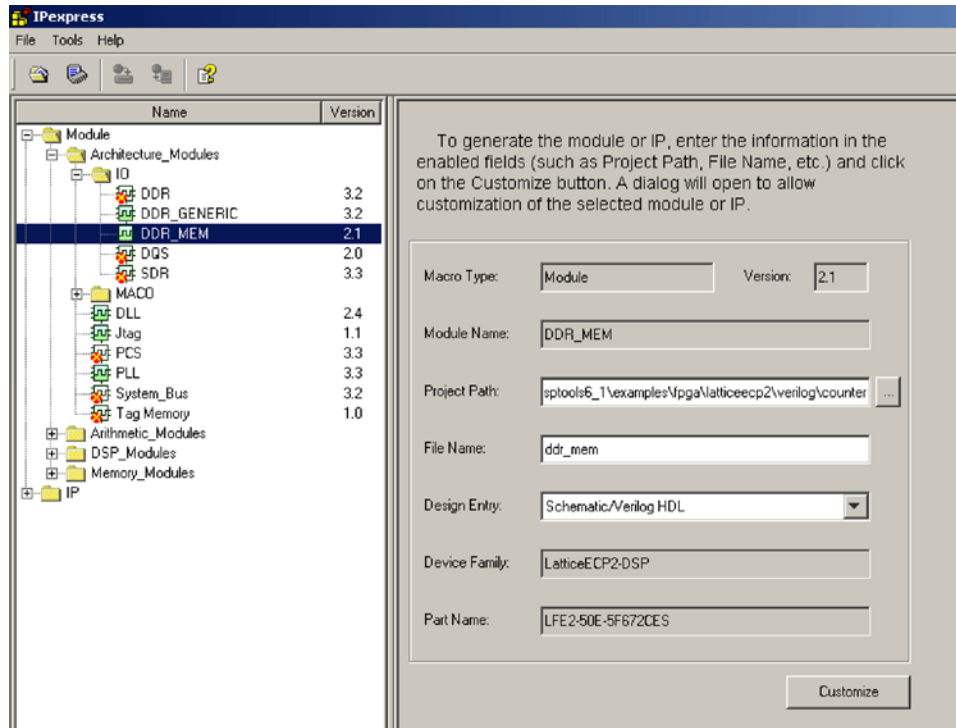
1. Only 1x available when Mode is Bidirection or Tristate.

DDR_MEM

Figure 12-45 shows the main window when DDR_MEM is selected. Similar to the DDR_Generic, the only entry required here is the module name. Other entries are set to the project settings. The user may change these entries

if desired. After entering the module name, click on **Customize** to open the **Configuration Tab** window as shown in Figure 12-46.

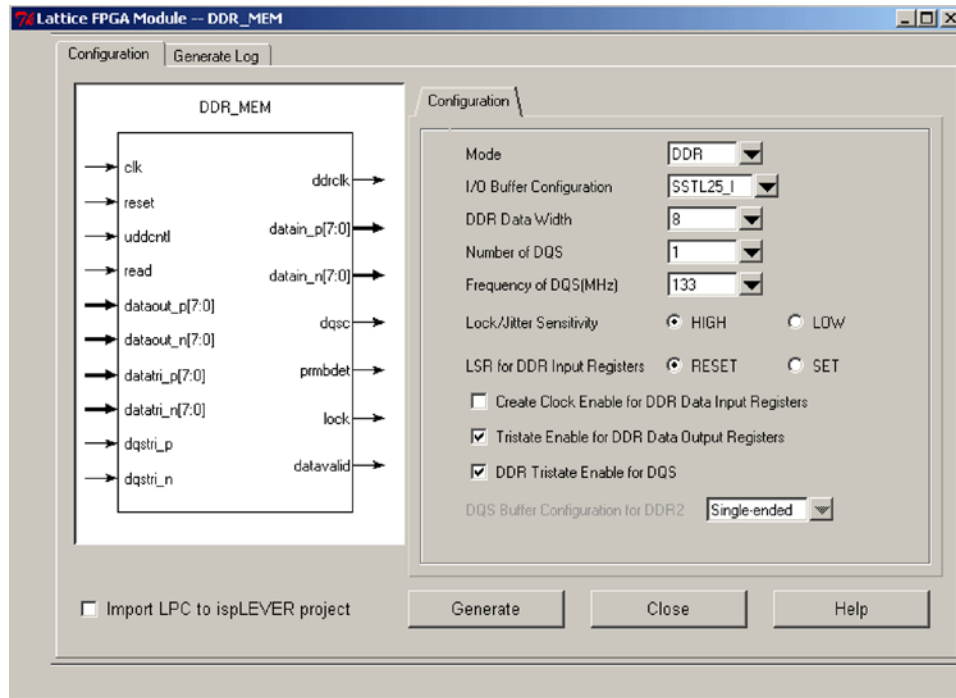
Figure 12-45. IPexpress Main Window for DDR_MEM



Configuration Tab

The Configuration Tab lists all user-accessible attributes with default values set. Upon completion, click **Generate** to generate source and constraint files. The user may choose to use the .lpc file to load parameters.

Figure 12-46. Configuration Tab for DDR_MEM



The user can change the Mode parameter to choose either the DDR or DDR2 interface. The other configuration parameters will change according to the Mode selected. The Number of DQS parameter determines the number of DDR interfaces. The software will assume there are eight data bits for every DQS. The user can also choose the frequency of operation and the DDR DLL will be configured to this frequency.

The user has an option to enable the clock enable and tristate enables for the DDR registers. It is recommend that the Lock/Jitter be enabled if the DDR interface is running at 150MHz or higher.

The parameters available depend on the mode selected. Tables 12-14 and 12-15 describe all user parameters in the IPexpress GUI and their usage for modes DDR and DDR2.

Table 12-14. User Parameters in the IPexpress GUI when in DDR Mode

| User Parameters | Description | Values/Range | Default |
|--|--|--------------------------------|----------|
| I/O Buffer Configuration | I/O Standard used for the Interface. This will also depend on the Mode selected. | SSTL25_I, SSTL25_II | SSTL25_I |
| Data Width | Width of the Data bus | 8-64 | 8 |
| Number of DQS | Number of DQS will determine the number of DQS Groups | 1, 2, 4, 8 | 1 |
| Frequency of DQS | DDR Interface Frequency. This is also input to the DDR DLL. The values will depend on the mode selected. | 100MHz, 133MHz, 166MHz, 200MHz | 200MHz |
| Lock/Jitter Sensitivity | DLL Sensitivity to Jitter | High, Low | High |
| LSR for DDR Input Register | LSR Control | RESET, SET | RESET |
| Create Clock Enable for DDR Input Register | Create Clock enable inputs to the block | On/Off | Off |
| Tri-state Enable for DDR Output Registers | Creates Tri-state control for the DDR data output registers. | On/Off | On |
| DDR Tristate enable for the DQS output | Creates Tristate control for DQS output | On/Off | On |

Table 12-15. User Parameters in the IPexpress GUI when in DDR2 Mode

| User Parameters | Description | Values/Range | Default |
|--|--|------------------------|----------|
| I/O Buffer Configuration | I/O Standard used for the Interface. This will also depend on the Mode selected. | SSTL18_I, SSTL18_II | SSTL18_I |
| Data Width | Width of the Data bus | 8-64 | 8 |
| Number of DQS | Number of DQS will determine the number of DQS Groups | 1, 2, 4, 8 | 1 |
| Frequency of DQS | DDR Interface Frequency. This is also input to the DDR DLL. The values will depend on the mode selected. | 166MHz, 200MHz, 266MHz | 200MHz |
| Lock/Jitter Sensitivity | DLL Sensitivity to Jitter | High, Low | High |
| LSR for DDR Input Register | LSR Control | RESET, SET | RESET |
| Create Clock Enable for DDR Input Register | Create Clock enable inputs to the block | On/Off | Off |
| Tri-state Enable for DDR Output Registers | Creates Tri-state control for the DDR data output registers. | On/Off | On |
| DDR Tristate enable for the DQS output | Creates Tristate control for DQS output | On/Off | On |
| DQS Buffer Configuration for DDR2 | DQS Buffer can be configured as Differential | On/Off | Off |

FCRAM (“Fast Cycle Random Access Memory”) Interface

FCRAM is a DDR-type DRAM, which performs data output at both the rising and falling edges of the clock. FCRAM devices operate at a core voltage of 2.5V with SSTL Class II I/O. It has enhanced both the core and peripheral logic of the SDRAM. In FCRAM the address and command signals are synchronized with the clock input, and the data pins are synchronized with the DQS signal. Data output takes place at both the rising and falling edges of the DQS. DQS is in phase with the clock input of the device. The DDR SDRAM and DDR FCRAM controller will have different pinouts.

LatticeECP2/M devices can implement the FCRAM interface using dedicated DQS logic, input DDR registers and output DDR registers, as described in the Implementing Memory Interfaces section of this document. Generation of address and control signals for FCRAM are different than in DDR SDRAM devices. Please refer to the FCRAM data sheets to see detailed specifications. Toshiba, Inc. and Fujitsu, Inc. offer FCRAM devices in 256Mb densities. They are available in x8 or x16 configurations.

Board Design Guidelines

The most common challenge associated with implementing DDR memory interfaces is the board design and layout. It is required that users strictly follow the guidelines recommended by memory device vendors.

Some of the common recommendations include matching trace lengths of interface signals to avoid skew, proper DQ-DQS signal grouping, proper termination of the SSTL2 or SSTL18 I/O Standard, proper VREF and VTT generation decoupling and proper PCB routing.

The following documents include board layout guidelines:

- www.idt.com, IDT, PCB Design for Double Data Rate Memory
- www.motorola.com, AN2582, Hardware and Layout Design Considerations for DDR Interfaces

References

- www.jedec.org, JEDEC Standard 79, Double Data Rate (DDR) SDRAM Specification
- www.micron.com, DDR SDRAM Data Sheets

- www.infinition.com, DDR SDRAM Data Sheets
- www.samsung.com, DDR SDRAM Data Sheets
- www.toshiba.com, DDR FCRAM Data Sheet
- www.fujitsu.com, DDR FCRAM Data Sheet
- RD1019, [QDR Memory Controller Reference Design](#)
- EB23, [LatticeECP2 Advanced Evaluation Board User's Guide](#)
- IPUG35, [DDR1 & DDR2 SDRAM Controller \(Pipelined Versions\) User's Guide](#)

Technical Support Assistance

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 +1-503-268-8001 (Outside North America)
 e-mail: techsupport@latticesemi.com
 Internet: www.latticesemi.com

Revision History

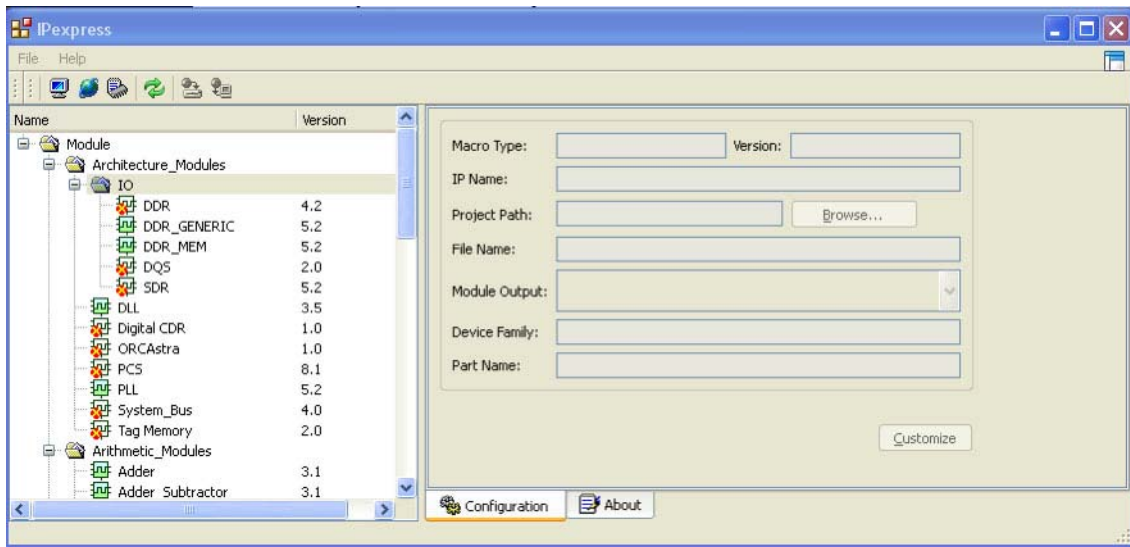
| Date | Version | Change Summary |
|----------------|---------|--|
| February 2006 | 01.0 | Original version. |
| September 2006 | 01.1 | Some figures updated. Added information on DELAYB block. |
| September 2006 | 01.2 | Updated for LatticeECP2M. Added "DDR Generic Usage in IPexpress" section. |
| February 2007 | 01.3 | Updated DDR and DDR2 SDRAM Interfaces Overview section. |
| June 2007 | 01.4 | Updated the port names on the input DDR block diagrams. |
| | | Updated text in the DQS Transition Detect under Memory Read Implementation section. |
| | | Updated the DQSDEL from 6-bit bus to single bit in figures 12-19 and 12-20. |
| | | Updated text in the DLL Compensated DQS Delay Elements section under Memory Read Implementation. |
| October 2007 | 01.5 | Updated DDRX2B Waveform diagram. |
| June 2009 | 01.6 | Updated DQSDLL Update Control text section. |
| January 2010 | 01.7 | Updated Read Data Transfer When Using IDDRMFX1A figure. |
| | | Updated Data Read Critical Path text section. |
| June 2010 | 01.8 | Added Appendix A. |

Appendix A. DDR Generation Using IPexpress with Lattice Diamond

The IPexpress tool in the Lattice Diamond design software can be used to configure and generate the DDR Memory Interface and Generic DDR Module. IPexpress will generate an HDL module that will contain the DDR primitives. This module can be using in the top level design.

Figure 12-47 shows the main window of IPexpress. The DDR_Generic and DDR_MEM options under **Architecture > IO** are used to configure the DDR modules.

Figure 12-47. IPexpress Main Window

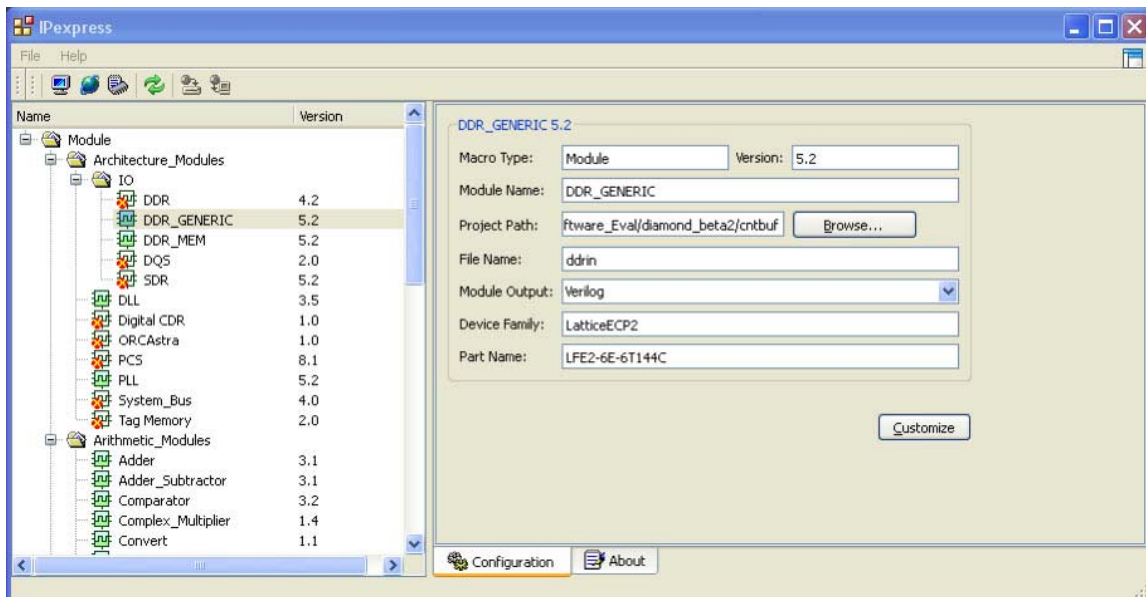


DDR Generic

Figure 12-48 shows the main window when DDR_Generic is selected. The only entry required in this window is the module name. Other entries are set to the project settings.

The user may change these entries if desired. After entering the module name, click on **Customize** to open the Configuration Tab window as shown in Figure 12-49.

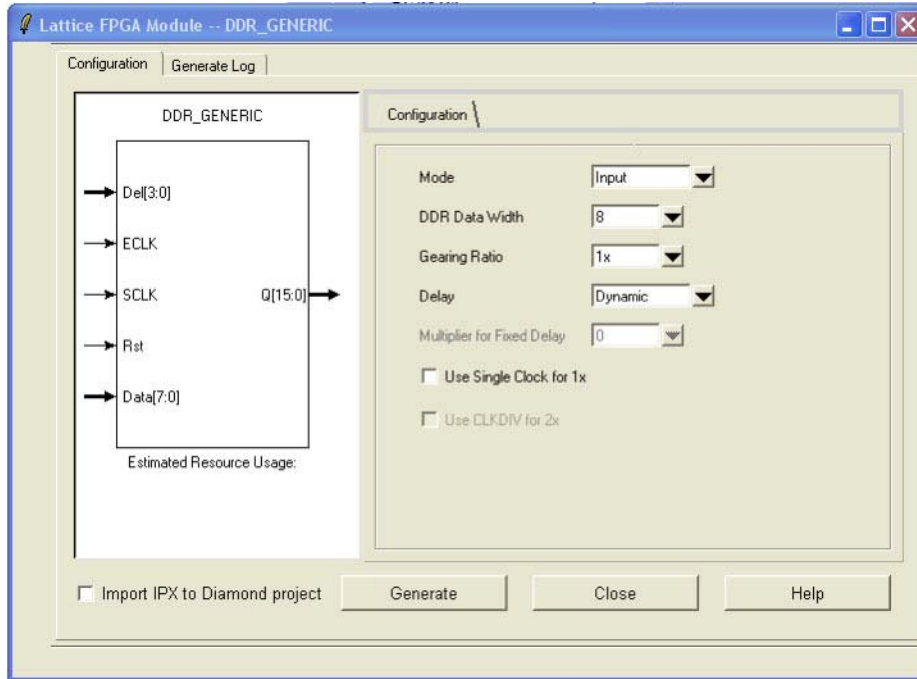
Figure 12-48. IPexpress Main Window for DDR_Generic



Configuration Tab

The Configuration Tab lists all user-accessible attributes with default values set. Upon completion, click **Generate** to generate source and constraint files. The user may choose to use the .lpc file to load parameters.

Figure 12-49. Configuration Tab for DDR_Generic



The user can change the Mode parameter to choose either the Input, Output, Bi-directional or Tristate DDR modules. The other configuration parameters will change according to the mode selected. The Delay parameter is only available for Input and Bi-directional modes. Similarly, the Multiplier for Fixed Delay parameter is only available when the Delay parameter is configured as Fixed.

Table 12-16. User Parameters in the IPexpress GUI

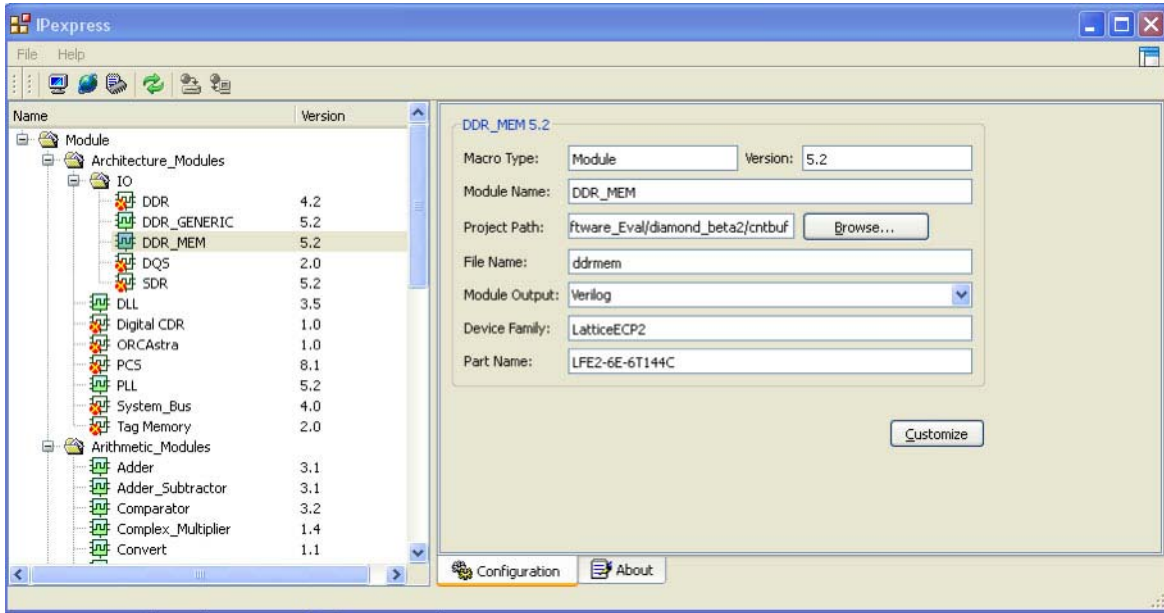
| User Parameters | Description | Values/Range | Default |
|----------------------------|--|--|---------|
| Mode | Mode selection for the DDR block. | Input, Output, Bidirectional, Tristate | Input |
| Data Width | Width of the data bus. | 1-64 | 8 |
| Gearing Ratio | Gearing ratio selection. | 1x, 2x ¹ | 1x |
| Delay | Input delay configuration. | Dynamic, Fixed, Fixed XGMII | Dynamic |
| Multiplier for Fixed Delay | Fixed delay setting. Available only when delay is configured as Fixed. | 0-15 | 0 |
| Use Single Clk for 1x | Allows the selection of a single clock for the gearing logic. | On/Off | Off |

1. Only 1x available when Mode is Bi-directional or Tristate.

DDR_MEM

Figure 12-50 shows the main window when DDR_MEM is selected. Similar to DDR_Generic, the only entry required here is the module name. Other entries are set to the project settings. The user may change these entries if desired. After entering the module name, click on **Customize** to open the Configuration Tab window as shown in Figure 12-51.

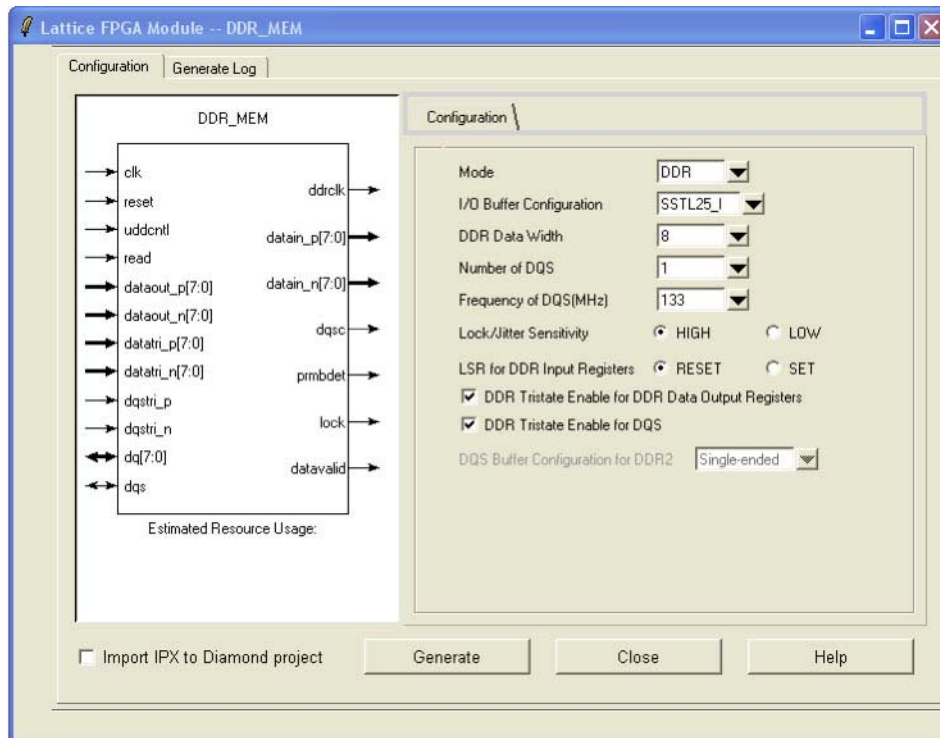
Figure 12-50. IPexpress Main Window for DDR_MEM



Configuration Tab

The Configuration Tab lists all user-accessible attributes with default values set. Upon completion, click **Generate** to generate source and constraint files. The user may choose to use the .lpc file to load parameters.

Figure 12-51. Configuration Tab for DDR_MEM



The user can change the Mode parameter to choose either the DDR or DDR2 interface. The other configuration parameters will change according to the Mode selected. The Number of DQS parameters determines the number

of DDR interfaces. The software will assume there are eight data bits for every DQS. The user can also choose the frequency of operation and the DDR DLL will be configured to this frequency.

The user has the option to enable the clock enable and tristate enables for the DDR registers. It is recommend that the Lock/Jitter be enabled if the DDR interface is running at 150 MHz or higher.

The parameters available depend on the mode selected. Tables 12-17 and 12-18 describe all user parameters in the IPexpress GUI and their usage for modes DDR and DDR2.

Table 12-17. User Parameters in the IPexpress GUI when in DDR Mode

| User Parameters | Description | Values/Range | Default |
|--|--|-----------------------------------|----------|
| I/O Buffer Configuration | I/O Standard used for the Interface. This will also depend on the Mode selected. | SSTL25_I, SSTL25_II | SSTL25_I |
| Data Width | Width of the Data bus | 8-64 | 8 |
| Number of DQS | Number of DQS will determine the number of DQS Groups | 1, 2, 4, 8 | 1 |
| Frequency of DQS | DDR Interface Frequency. This is also input to the DDR DLL. The values will depend on the mode selected. | 100MHz, 133MHz, 166MHz, 200MHz | 200MHz |
| Lock/Jitter Sensitivity | DLL Sensitivity to Jitter | High, Low | High |
| LSR for DDR Input Register | LSR Control | RESET, SET | RESET |
| Create Clock Enable for DDR Input Register | Create Clock enable inputs to the block | On/Off | Off |
| Tri-state Enable for DDR Output Registers | Creates Tri-state control for the DDR data output registers. | On/Off | On |
| DDR Tristate enable for the DQS output | Creates Tristate control for DQS output | On/Off | On |

Table 12-18. User Parameters in the IPexpress GUI when in DDR2 Mode

| User Parameters | Description | Values/Range | Default |
|--|--|------------------------|----------|
| I/O Buffer Configuration | I/O Standard used for the Interface. This will also depend on the Mode selected. | SSTL18_I, SSTL18_II | SSTL18_I |
| Data Width | Width of the Data bus | 8-64 | 8 |
| Number of DQS | Number of DQS will determine the number of DQS Groups | 1, 2, 4, 8 | 1 |
| Frequency of DQS | DDR Interface Frequency. This is also input to the DDR DLL. The values will depend on the mode selected. | 166MHz, 200MHz, 266MHz | 200MHz |
| Lock/Jitter Sensitivity | DLL Sensitivity to Jitter | High, Low | High |
| LSR for DDR Input Register | LSR Control | RESET, SET | RESET |
| Create Clock Enable for DDR Input Register | Create Clock enable inputs to the block | On/Off | Off |
| Tri-state Enable for DDR Output Registers | Creates Tri-state control for the DDR data output registers. | On/Off | On |
| DDR Tristate enable for the DQS output | Creates Tristate control for DQS output | On/Off | On |
| DQS Buffer Configuration for DDR2 | DQS Buffer can be configured as Differential | On/Off | Off |

Introduction

Power considerations in FPGA design are critical for determining the maximum system power requirements and sequencing requirements of the FPGA on the board. This technical note provides users with detailed power considerations such as sequencing. Also included are instructions for calculating power consumption in LatticeECP2™ and LatticeECP2M™ devices using the Power Calculator available in the Lattice ispLEVER[®] design tool. General guidelines for reducing power consumption are also discussed.

Power Supply Sequencing

Power-Up Sequencing

There are three main power supplies that are required to power-up the LatticeECP2/M device for proper operation: V_{CC} , V_{CCAUX} and V_{CCIO8} . Bank 8, or V_{CCIO8} , powers the sysCONFIG™ port and configuration circuitry and is therefore required during power-up.

The nominal voltages for these power supplies are 1.2V for V_{CC} , 3.3V for V_{CCAUX} and 1.2V to 3.3V for V_{CCIO8} . The nominal trip points for these power supplies are 0.6V to 0.8 V for V_{CC} and V_{CCIO8} , and 2.2V to 2.5V for V_{CCAUX} . For power supply sequencing, refer to the Recommended Operation Conditions section of the [LatticeECP2/M Family Data Sheet](#).

Each power supply must follow a monotonically clean ramp between the trip points and the minimum required supply voltage. Note that for slow ramps (when the power-up ramp rate is 10s or 100s milliseconds) it is critical that the ramp is clean and monotonic. The device may go in and out of the power-up reset if the ramp is unclean and non-monotonic, especially around the trip point. This also applies when powering down the device. A clean, monotonic ramp will ensure that the device will power up and power down properly.

After initialization is complete, if any V_{CC} , V_{CCAUX} or V_{CCIO8} drops below its power-down trip point, the device will reset. Any $V_{CCIO[7:0]}$ can be removed without resetting the device after initialization is complete.

Refer to the [LatticeECP2/M Family Data Sheet](#) and TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#), for configuration timing and power-up information.

Power-Down Sequencing

During power-down, power should be removed from one of the supplies' V_{CC} , V_{CCAUX} or V_{CCIO8} first to ensure that no high currents are seen on the input pins as the other V_{CCIO} supplies are removed. This only applies when input signals are still being driven, such as in hot-socketing applications.

For non-hot-socketing applications, the input signals are likely to be powered from the same supply as V_{CCIO} . Therefore, they will usually be less than or equal to V_{CCIO} during power down.

Power Sequencing Recommendations

LatticeECP2/M devices do not have a power-up sequence requirement. The supplies can be brought up in any sequence.

In order to minimize the transients and hot socketing currents during power up, Lattice recommends that the V_{CC} be brought up before V_{CCAUX} or V_{CCIO8} . Additionally, V_{CC} should reach its minimum voltage value before V_{CCAUX} and V_{CCIO8} reach their minimum values. When removing the supplies, V_{CCAUX} or V_{CCIO8} must be removed before V_{CC} is turned off.

Note that this this sequence is not a requirement for LatticeECP2/M devices.

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For LatticeECP2MS power-up sequencing, refer to the Recommended Operation Conditions section of the [LatticeECP2/M Family Data Sheet](#).

Power Calculator Hardware Assumptions

The Power Calculator reports the power dissipation in terms of:

1. DC portion of the power consumption
2. AC portion of the power consumption

Total power dissipation is the sum of the static (DC) and dynamic (AC) power dissipations of a device. While DC power depends upon voltage, temperature and process variation, AC power is a strong function of the frequency and the activity of the resources and a weak function of voltage, temperature and process.

Static Power or DC Power

DC power can be further subdivided into the power consumption of the used and unused resources. Another important term is Quiescent Power, the DC power for a blank (BE or Bulk Erase) device. In the Bulk Erase mode, none of the resources are used, so it is the total DC power of an unused device.

The AC portion of the power consumption, associated with used resources, is the dynamic part of the power consumption. AC power dissipation is directly proportional to the frequency and activity at which the resource is running and the number of resource units used.

Junction Temperature

For a fixed temperature, voltage and device package combination, quiescent power is fixed.

Ambient temperature that affects the junction temperature is a factor that contributes to the final power consumption.

Power Calculator models this ambient-to-junction temperature dependency. When a user provides an ambient temperature, it is rolled into an algorithm which calculates the junction temperature and quiescent power through an iterative process.

Typical and Worst Case Process Power/ I_{CC}

Another factor that affects the DC power is process variation. This variation in turn causes variation in quiescent power.

Power Calculator takes these factors into account and allows users to specify either a typical process or a worst case process.

- A typical process selection under Device Variation allows users to calculate the power dissipation of a design using a typical process device.
- The worst case selection under the same option provides the maximum power dissipation for the device and package combination. This information is particularly useful for FPGA power budgeting for the entire system.

Dynamic Power Budgets and Maximum Operating Temperature

When designing a system, designers must make sure a device operates at specified temperatures within the system environment. This is particularly important to consider before a system is designed. With Power Calculator, users can predict device thermodynamics and estimate the dynamic power budget. The ability to estimate a device's operating temperature prior to board design also allows the designer to better plan for power budgeting and airflow.

Although total power, ambient temperature, thermal resistance and airflow all contribute to device thermodynamics, the junction temperature (as specified in the device data sheet) is the key to device operation. The allowed junction temperature range is 0°C to 85°C for commercial devices and -40°C to 100°C for industrial devices. Any time the junction temperature of the die falls out of these ranges, the performance and reliability of the device's operation

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must be evaluated. The reliability limit of junction temperature, on the other hand, for this generation of device technology is 125°C.

Let us consider an example for how to determine and use the Power Calculator for thermal analysis. Once the user has imported or provided all the required information in the Power Calculator, the software will provide the power estimation and predict the Junction Temperature (T_J). Any time this junction temperature is outside the limits specified in the device data sheet, the viability of operating the device at this junction temperature must be re-evaluated. A commercial device is likely to show speed degradation with a junction temperature above 85°C and an industrial device at a junction temperature will degrade above 100°C. It is required that the die temperature be kept below these limits to achieve the guaranteed speed operation.

Operating a device at a higher temperature also means a higher SICC. The difference between the SICC and the total ICC (both Static ICC and Dynamic ICC) at a given temperature provides the dynamic budget available. If the device runs at a dynamic ICC higher than this budget, the total ICC is also higher. This causes the die temperature to rise above the specified operating conditions.

There are a number of ways to handle this situation. Some of these are discussed in the Power Management section of this document. The four factors listed earlier in this section, namely power, ambient temperature, thermal resistance and airflow, can also be varied and controlled to reduce the junction temperature of the device.

Power Calculator is a powerful tool to help system designers properly budget the FPGA power that in turn helps improve the overall system reliability.

Power Calculator

Power Calculator is a powerful tool that allows users to estimate power consumption at two different levels:

1. Estimate of the utilized resources before completing place and route
2. Post place and route design

At a coarse level of estimation, the user provides estimates of device usage in the Power Calculator Wizard and the tool provides a rough estimate of the power consumption.

For a more accurate approach, a designer can import actual device utilization by importing the post Place and Route netlist (NCD) file.

Power Calculation Equations

The following are the power equations used in the Power Calculator:

$$\begin{aligned} \text{Total DC Power (Resource)} &= \text{Total DC Power of Used Portion} + \text{Total DC Power of Unused Portion} \\ &= [\text{DC Leakage per Resource when Used} * N_{\text{RESOURCE}}] \\ &\quad + [\text{DC Leakage per Resource when Unused} * (N_{\text{TOTAL RESOURCE}} - N_{\text{RESOURCE}})] \end{aligned}$$

Where:

$N_{\text{TOTAL RESOURCE}}$ is the total number of Resources in a device.

N_{RESOURCE} is the number of Resources used in the design.

The total DC power consumption for all the resources as per the design data is the sum of the quiescent power and the individual DC power of the resources in the Power Calculator.

$$\begin{aligned} \text{Total DC Power (I}_{\text{CCAUX}}) &= K_{\text{RESOURCE}} * 525 \mu\text{A} + \text{Typical Standby I}_{\text{CCAUX}} \end{aligned}$$

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Where:

$K_{RESOURCE}$ is the number of reference input I/O such as HSTL/SSTL. For LVDS $K_{RESOURCE}$ is number of inputs divided by two.

I_{CCAUX} is a DC current that does not change with I/O toggle rate or temperature.

Typical Standby I_{CCAUX} is found in the data sheet.

The AC power, on the other hand, is governed by the following equation:

$$\begin{aligned} \text{Total AC Power (Resource)} \\ = K_{RESOURCE} * f_{MAX} * AF_{RESOURCE} * N_{RESOURCE} \end{aligned}$$

Where:

$N_{RESOURCE}$ is the number of resources used in the design.
 $K_{RESOURCE}$ is the power constant for the resource in mW/MHz.
 f_{MAX} is the max. frequency at which the resource is running. Frequency is measured in MHz.
 $AF_{RESOURCE}$ is the activity factor for the resource group. The Activity Factor is a percentage of the switching frequency.

For example, the power consumption of the LUT is calculated as per the following equation,

$$\begin{aligned} \text{Total AC Power (LUT)} \\ = K_{LUT} * f_{MAX} * AF_{LUT} * N_{LUT} \end{aligned}$$

Where:

N_{LUT} is the number of LUTs used in the design.
 K_{LUT} is the Power constant for the LUT blocks in mW/MHz.
 f_{MAX} is the max. frequency of the LUT clock measured in MHz.
 AF_{LUT} is the activity factor for the LUT. The Activity Factor is a percentage of the switching frequency.

Another example is the power consumption of the EBR block, which is calculated as follows:

$$\begin{aligned} \text{Total AC Power (EBR)} \\ = K_{EBR} * f_{MAX} * AF_{EBR} * N_{EBR} \end{aligned}$$

Where:

N_{EBR} is the number of EBR blocks used in the design.
 K_{EBR} is the power constant for the EBR blocks in mW/MHz.
 F_{MAX} is the max. frequency of the EBR clock measured in MHz.
 AF_{EBR} is the activity factor for the Read and Write ports of the EBR. The Activity Factor is a percentage of the switching frequency.

Also note that the LUT can be configured in Logic, Ripple or Distributed RAM modes. Each of these modes has a different power constant/power coefficient. However, the equations stay the same.

The AC power of some of the dedicated blocks can be calculated using the following equation:

$$\begin{aligned} \text{Total AC Power (Dedicated Resource)} \\ = K_{RESOURCE} * f_{MAX} * N_{RESOURCE} \end{aligned}$$

Where:

$N_{RESOURCE}$ is the number of resources used in the design.
 $K_{RESOURCE}$ is the power constant for the resource in mW/MHz.
 f_{MAX} is the max. frequency at which the resource is running measured in MHz.

Activity Factor Calculation

The Activity Factor % (or AF%) is defined as the percentage of frequency (or time) that a signal is active or toggling the output.

Most resources associated with a clock domain are running or toggling at some percentage of the frequency at which the clock is running. Users must provide this value as a percentage under the AF% column in the Power Calculator tool.

Another term for I/Os is the I/O Toggle Rate. The AF% is applicable to the PFU, Routing, and Memory Read Write Ports, etc. The activity of I/Os is determined by the signals provided by the user (in the case of inputs) or as an output of the design (in the case of outputs). The rates at which I/Os toggle define their activity. The I/O Toggle Rate or the I/O Toggle Frequency is a better measure of their activity.

The Toggle Rate (or TR) in MHz of the output is defined in the following equation:

$$\text{Toggle Rate (MHz)} = 1/2 * f_{\text{MAX}} * \text{AF\%}$$

Users are required to provide the TR (MHz) value for the I/O instead of providing the frequency and AF% for other resources.

AF can be calculated for each routing resource, output or PFU. However, this involves long calculations. The general recommendation for a design occupying roughly 30% to 70% of the device is an AF% between 15% and 25%. This is an average value. The accurate value of an AF depends upon clock frequency, stimulus to the design and the final output.

Ambient and Junction Temperatures and Airflow

A common method of characterizing a packaged device's thermal performance is with Thermal Resistance, θ . In a semiconductor device, thermal resistance indicates the steady state temperature rise of the die junction above a given reference for each watt of power (heat) dissipated at the die surface. Its units are °C/W.

The most common examples are θ_{JA} , Thermal Resistance Junction-to-Ambient (in °C/W) and θ_{JC} , Thermal Resistance Junction-to-Case (also in °C/W). Another factor is θ_{JB} , Thermal Resistance Junction-to-Board (in °C/W).

Knowing the reference (i.e. ambient, case or board) temperature, the power and the relevant θ value, the junction temperature can be calculated as follows.

$$T_J = T_A + \theta_{JA} * P \quad (1)$$

$$T_J = T_C + \theta_{JC} * P \quad (2)$$

$$T_J = T_B + \theta_{JB} * P \quad (3)$$

Where T_J , T_A , T_C and T_B are the Junction, Ambient, Case (or Package) and Board temperatures (in °C) respectively. P is the total power dissipation of the device.

θ_{JA} is commonly used with natural and forced convection air-cooled systems. θ_{JC} is useful when the package has a high conductivity case mounted directly to a PCB or heat sink. θ_{JB} applies when the board temperature adjacent to the package is known.

Power Calculator utilizes the ambient temperature (°C) to calculate the junction temperature (°C) based on the θ_{JA} for the targeted device, per equation 1 above. Users can also provide the airflow values (in LFM) to get a more accurate value of the junction temperature.

Managing Power Consumption

One of the most critical factors in design today is reducing the system power consumption. Low power consumption is especially important for hand-held devices and other modern electronic products. There are several design techniques that can significantly reduce overall system power consumption. These include:

1. Reducing the operating voltage.
2. Operating within the specified package temperature limitations.
3. Using optimum clock frequency to reduce power consumption, as the dynamic power is directly proportional to the frequency of operation. Designers must determine if a portion of their design can be clocked at a lower rate, which will reduce power.
4. Reducing the span of the design across the device. A more closely placed design utilizes fewer routing resources for less power consumption.
5. Reducing the voltage swing of the I/Os where possible.
6. Using optimum encoding where possible. For example, a 16-bit binary counter has, on average, only 12% Activity Factor and a 7-bit binary counter has an average of 28% Activity Factor. On the other hand, a 7-bit Linear Feedback Shift Register can toggle as much as 50% Activity Factor, which causes higher power consumption. A gray code counter, where only one bit changes at each clock edge, will use the least amount of power, as the Activity Factor is less than 10%.
7. Minimizing the operating temperature, by the following methods:
 - a. Use packages that can better dissipate heat. For example, packages with lower thermal impedance.
 - b. Place heat sinks and thermal planes around the device on the PCB.
 - c. Better airflow techniques using mechanical airflow guides and fans (both system fans and device-mounted fans).

Power Calculator Assumptions

The following are the assumptions made by the Power Calculator:

1. The Power Calculator tool uses equations with constants based on a room temperature of 25°C.
2. The user can define the Ambient Temperature (T_A) for device Junction Temperature (T_J) calculation based on the power estimation. T_J is calculated from the user-entered T_A and the power calculation of typical room temperature.
3. I/O power consumption is based on an output loading of 5pF. Users have the ability to change this capacitive loading.
4. Users can estimate power dissipation and current for each type of power supplies that are V_{CC} , V_{CCIO} , V_{CCJ} , and V_{CCAUX} . For V_{CCAUX} , only static I_{CCAUX} values are provided in the Power Calculator.
Additional V_{CCAUX} contributions due to differential output buffers, differential input buffers and reference input buffers must be added per pair for differential buffers or per pin for reference input buffers according to the user's design. See the equation given in this technical note for Total DC Power (I_{CCAUX}).
5. The nominal V_{CC} is used by default to calculate the power consumption. A lower or higher V_{CC} can be chosen from a list of available values.
6. Users can enter an Airflow in Linear Feet per Minute (LFM) along with a Heat Sink option to calculate the Junction Temperature.
7. The default value of the I/O types for the LatticeECP2/M devices is LVCMOS12, 6mA.
8. The Activity Factor is defined as the toggle rate of the registered output. For example, assuming that the input of a flip-flop is changing at every clock cycle, 100% AF of a flip-flop running at 100MHz is 50MHz.

Technical Support Assistance

Hotline: 1-800-LATTICE (North America)
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e-mail: techsupport@latticesemi.com
Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|--|
| February 2006 | 01.0 | Initial release. |
| September 2006 | 01.1 | Updated for LatticeECP2/M. |
| | | Added discussion on Dynamic Power Budgets and Junction Temperature. |
| November 2006 | 01.2 | Added calculation of I_{CCAUX} in Power Calculation Equations section. |
| January 2007 | 01.3 | Updated Power Supply Sequencing section. |
| November 2009 | 01.4 | Updated Power-up Sequencing text section. |
| | | Updated Power Sequencing Recommendations text section. |

Introduction

This technical note discusses how to access the features of the LatticeECP2™ and LatticeECP2M™ sysDSP™ (Digital Signal Processing) Block described in the [LatticeECP2/M Family Data Sheet](#). Designs targeting the sysDSP Block can offer significant improvement over traditional LUT-based implementations. Table 14-1 provides an example of the performance and area benefits of this approach:

Table 14-1. sysDSP Block vs. LUT-based Multipliers

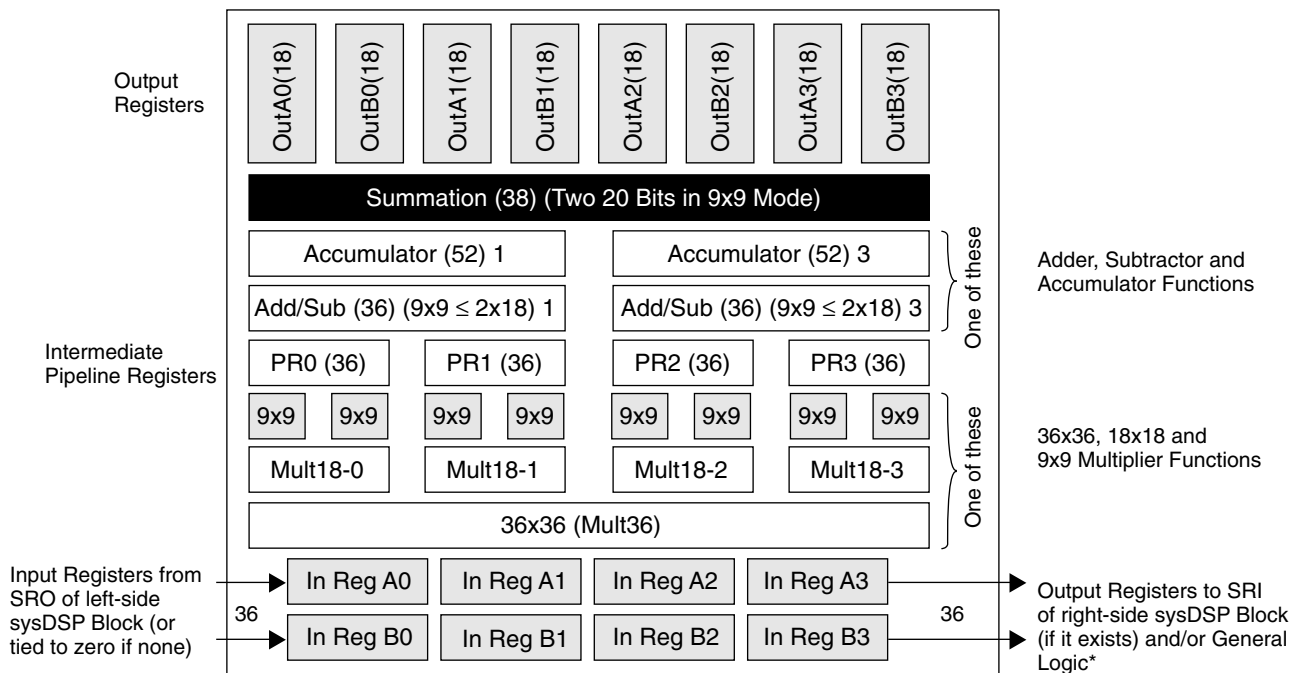
| Multiplier Width | Register Pipelining | LatticeECP2-50-7 Uses One sysDSP Block | | LatticeECP2-50-7 Uses LUTs | |
|------------------|---------------------------|---|------|-------------------------------------|------|
| | | f _{MAX} (MHz) ¹ | LUTs | f _{MAX} (MHz) ¹ | LUTs |
| 9x9 | Input, Multiplier, Output | 404 | 0 | 124 | 192 |
| 18x18 | Input, Multiplier, Output | 420 | 0 | 95 | 698 |
| 36x36 | Input, Multiplier, Output | 371 | 0 | 61 | 2732 |

1. These timing numbers were generated using the ispLEVER[®] design tool. Exact performance may vary with design and tool version.

sysDSP Block Hardware

The LatticeECP2/M sysDSP Blocks are located in rows throughout device. Below is a block diagram of one of the sysDSP Blocks:

Figure 14-1. LatticeECP2/M sysDSP Block



*Can only be routed to general logic routing when configured with less than three MULT18X18.

Note: Each sysDSP Block spans nine columns of PFUs.

The sysDSP Block can be configured as:

- One 36x36 Multiplier
 - Basic multiplier, no add/sub/accum/sum blocks
- Four 18x18 Multipliers
 - Two add/sub/accum blocks
 - One summation block for adding four multipliers
- Eight 9x9 Multipliers
 - Four add/sub blocks
 - Two summation blocks

Note that a sysDSP block can only be configured in one mode at a time.

sysDSP Block Software

Overview

The sysDSP Block of the LatticeECP2/M device can be targeted in a number of ways.

- The IPexpress™ tool in the ispLEVER or Lattice Diamond™ design software allows the rapid creation of modules implementing sysDSP elements. These modules can then be used in HDL designs as appropriate.
- The coding of certain functions into a design's HDL and allowing the synthesis tools to Inference the use of a sysDSP block.
- The implementation of designs in The MathWorks® Simulink® tool using a Lattice block set. The ispLEVER sysDSP design tools will then convert these blocks into HDL as appropriate.
- Instantiation of sysDSP primitives directly in the source code

Targeting sysDSP Block Using IPexpress

IPexpress allows you to graphically specify sysDSP elements. Once the element is specified, a HDL file is generated, which can be instantiated in a design. IPexpress allows users to configure all ports and set all available parameters. The following modules target the sysDSP Block in IPexpress:

- MULT (Multiplier)
- MAC (Multiplier Accumulate)
- MULTADDSUB (Multiplier Add/Subtract)
- MULTADDSUBSUM (Multiply Add/Subtract and SUM)

Note: See Appendix B for information about targeting a sysDSP Block using Lattice Diamond design software and IPexpress.

MULT Module

The MULT Module configures elements to be packed into the sysDSP primitives. The Basic mode screen illustrated in Figure 14-2 consists of an optional one clock, one clock enable and one reset tied to all registers. Multiple sysDSP Blocks can be spanned to accommodate large multiplications. Additional LUTs may be required if multiple sysDSP blocks are needed. Select **Area/Speed** to determine the LUT implementation. The input data format can be selected as Parallel, Shift or Dynamic. The Shift format can only be enabled if inputs are less than 18 bits. The Shift format enables a sample/shift register, which is useful in applications such as the FIR filter. The Advanced mode screen, illustrated in Figure 14-3, allows finer control over the register. In the Advanced mode, users can control each register with independent clocks, clock enables and resets. MULT inputs can be from 2 to 72 bits.

Figure 14-2. MULT Mode Basic Set-up

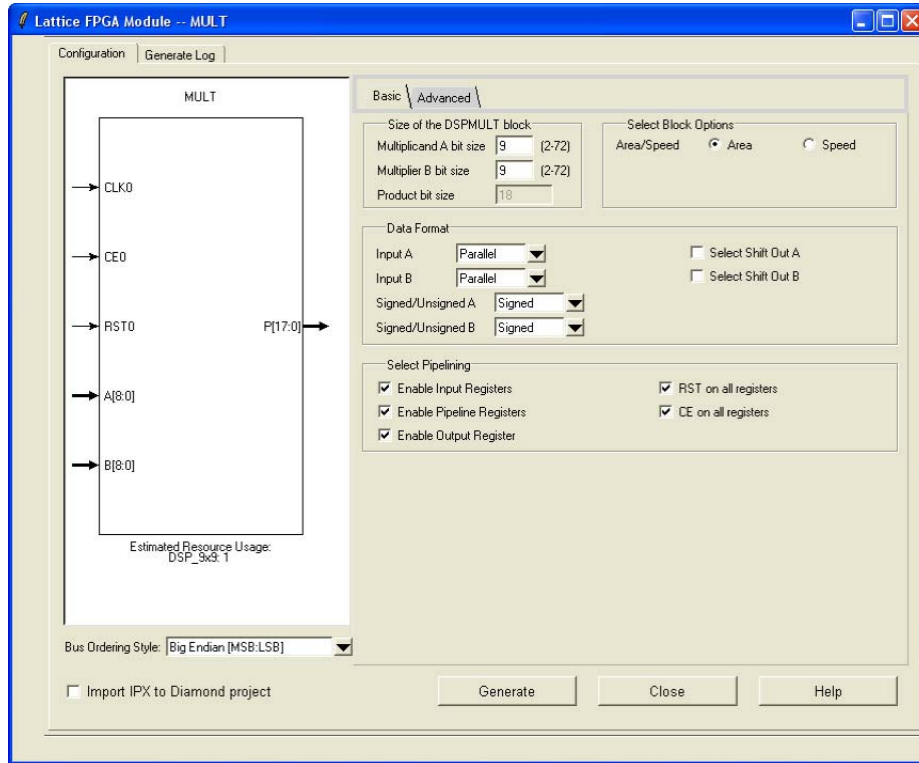
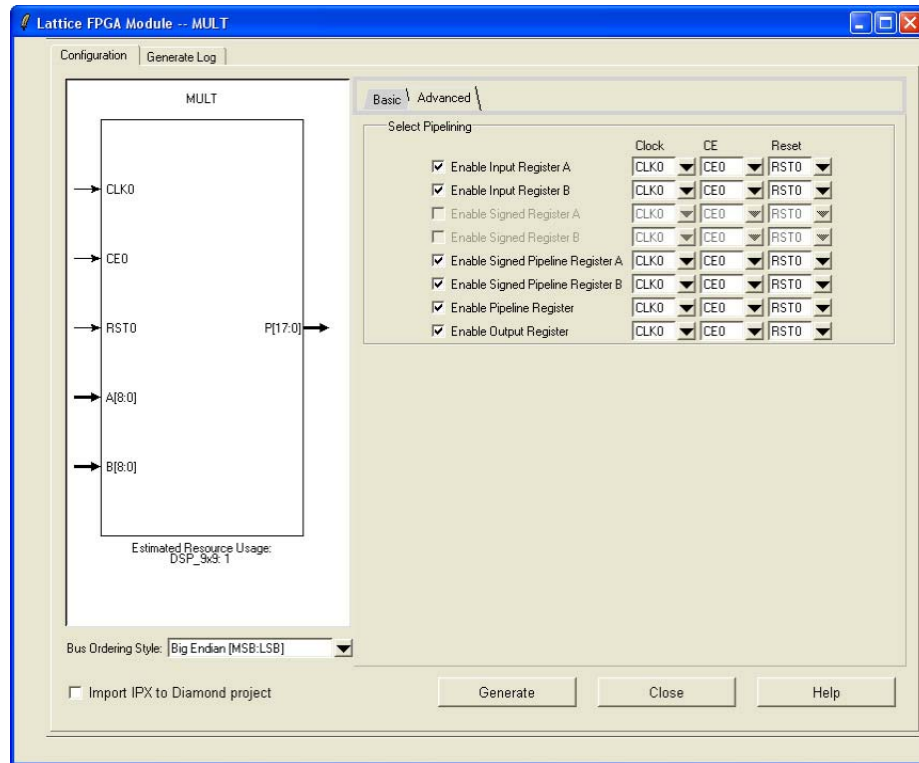


Figure 14-3. MULT Mode Advanced Set-up



MAC Module

The MAC Module configures multiply accumulate elements to be packed into the primitive MULT18X18MACB. The Basic mode, shown in Figure 14-4, consists of an optional one clock, one clock enable and one reset tied to all registers. Because of the accumulator, the output register is automatically enabled. Multiple sysDSP Blocks can be spanned to accommodate large multiplications. The accumulator of the sysDSP block is 52 bits deep and additional LUTs can be used if a larger accumulation is required. If sysDSP blocks are spanned, additional LUT logic may be required. Select **Area/Speed** to determine the LUT implementation. The input data format can be selected as Parallel, Shift or Dynamic. The Shift format can only be enabled if inputs are less than 18 bits. The Shift format enables a sample/shift register. The Accumload loads the accumulator with the value from the LD port. This is required to initialize and load the first value of the accumulation. The Advanced mode, shown in Figure 14-5, allows finer control over the registers. In the advanced mode, users can control each register with independent clocks, clock enables and resets. MAC inputs can be from 2 to 72 bits.

Figure 14-4. MAC Mode Basic Set-up

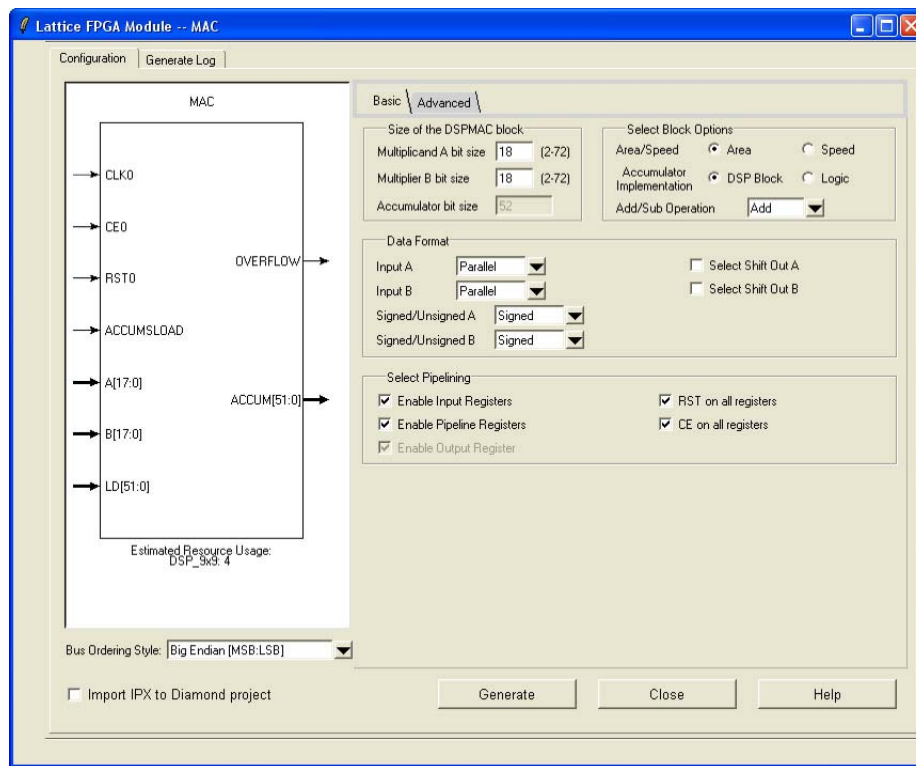
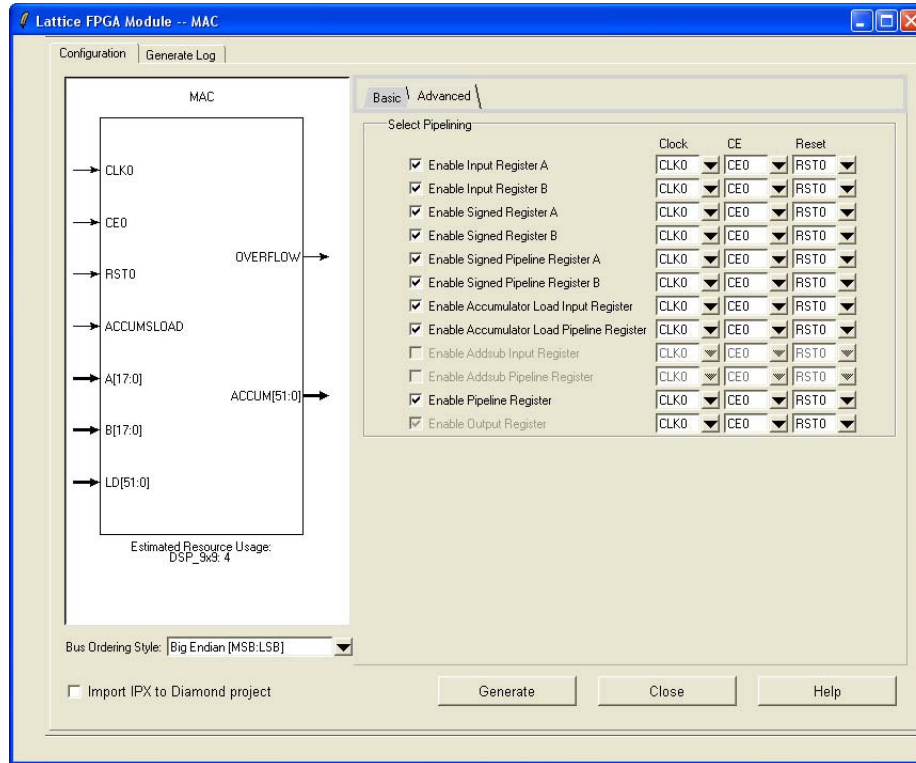


Figure 14-5. MAC Mode Advanced Set-up



MULTADDSUB Module

The MULTADDSUB GUI configures multiplier addition/subtraction elements to be packed into the primitives MULT18X18ADDSUBB or MULT9X9ADDSUBB. The Basic mode, shown in Figure 14-6, consists of an optional one clock, one clock enable and one reset tied to all registers. Multiple sysDSP Blocks can be spanned to accommodate large multiplications. If sysDSP blocks are spanned, additional LUT logic may be required. Select **Area/Speed** to determine the LUT implementation. The input data format can be selected as Parallel, Shift or Dynamic. The Shift format can only be enabled if inputs are less than 18 bits. The Shift format enables a sample/shift register, which is useful in applications such as the FIR filter. The Advanced mode, shown in Figure 14-7, provides finer control over the registers. In the advanced mode, users can control each register with independent clocks, clock enables and resets. MULTADDSUB inputs can be from 2 to 72 bits.

Figure 14-6. MULTADDSUB Mode Basic Set-up

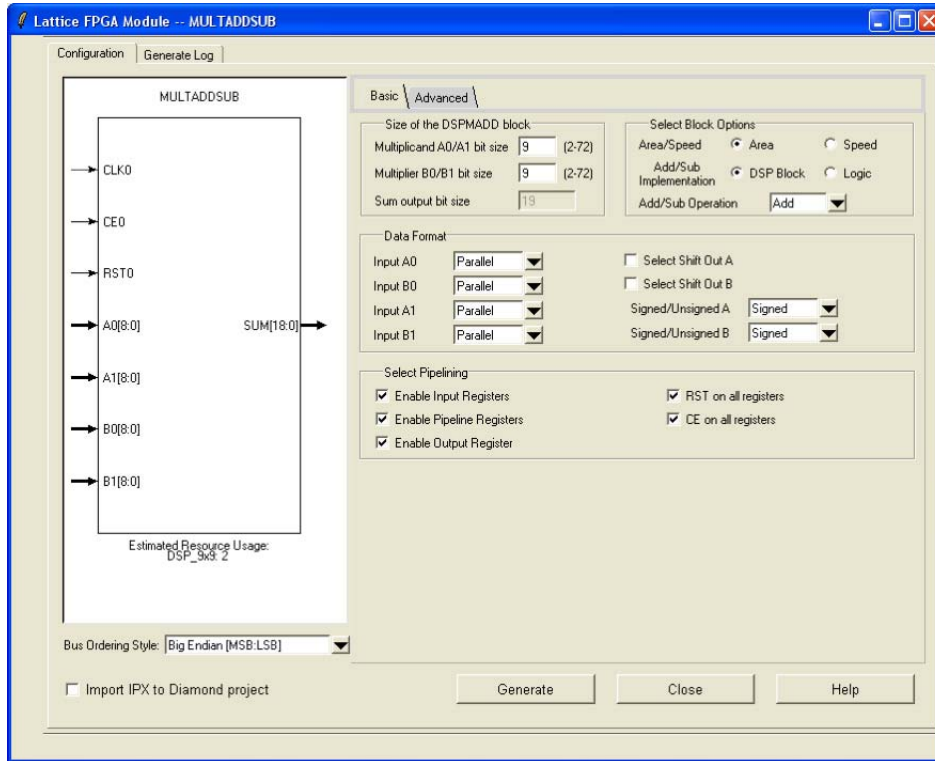
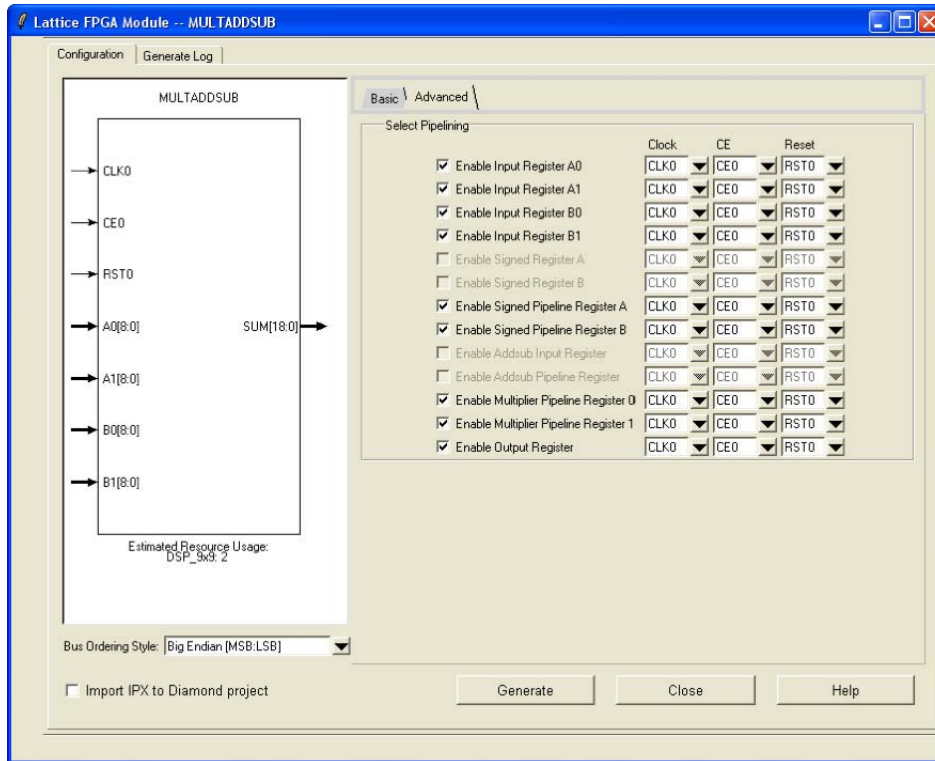


Figure 14-7. MULTADDSUB Mode Advanced Set-up



MULTADDSUBSUM Module

The MULTADDSUBSUM GUI configures Multiplier Addition/Subtraction Addition elements to be packed into the primitives MULT18X18ADDSUBSUMB or MULT9X9ADDSUBSUMB. The Basic mode, shown in Figure 14-8, consists of an optional one clock, one clock enable and one reset tied to all registers. Multiple sysDSP Blocks can be spanned to accommodate large multiplications. If sysDSP blocks are spanned, additional LUT logic may be required. Select **Area/Speed** to determine the LUT implementation. The input data format can be selected as Parallel, Shift or Dynamic. The Shift format is can only be enabled if inputs are less than 18 bits. The Shift format enables a sample/shift register, which is useful in applications such as the FIR filter. The Advanced mode, shown in Figure 14-9, provides finer control over the registers. In the advanced mode, users can control each register with independent clocks, clock enables and resets. MULTADDSUBSUM inputs can be from 2 to 72 bits.

Figure 14-8. MULTADDSUBSUM Mode Basic Set-up

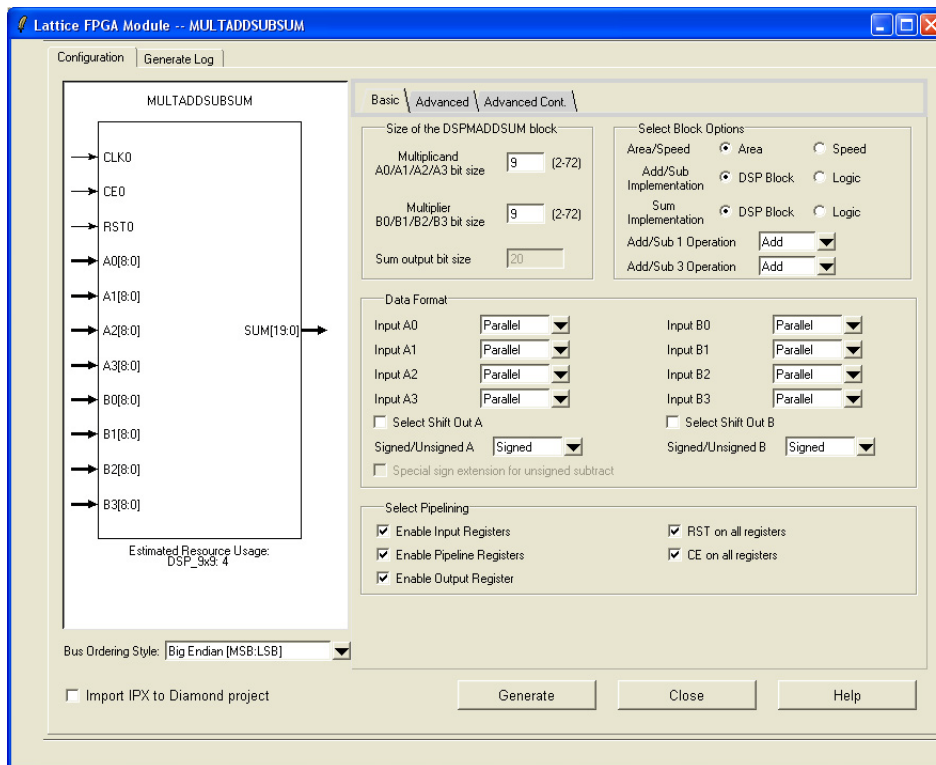


Figure 14-9. MULTADDSUBSUM Mode Advanced

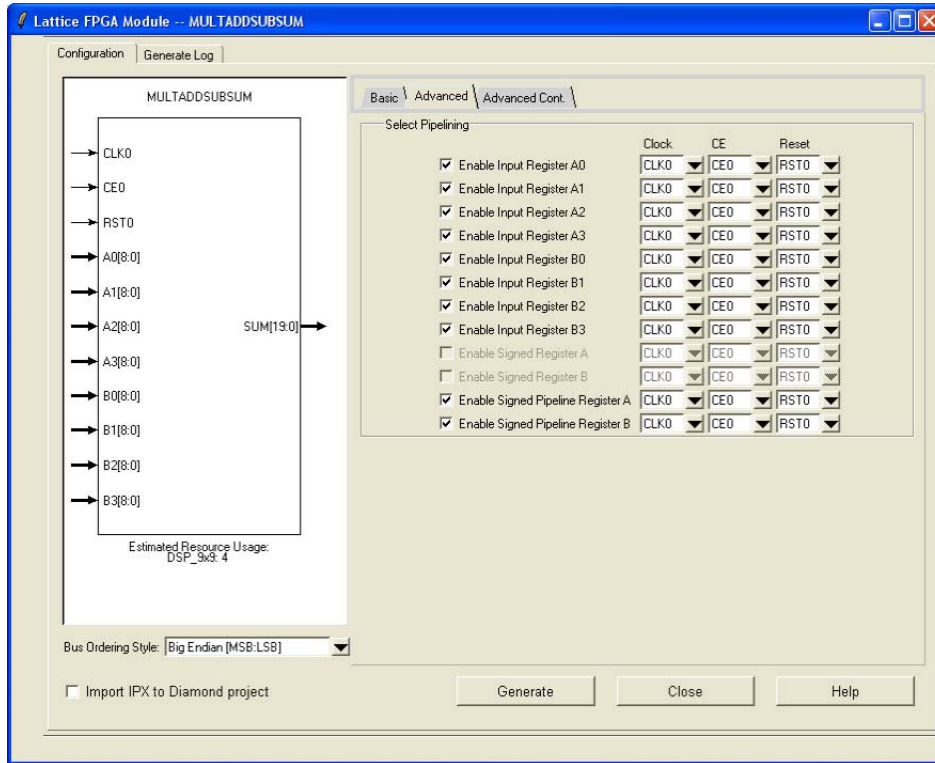
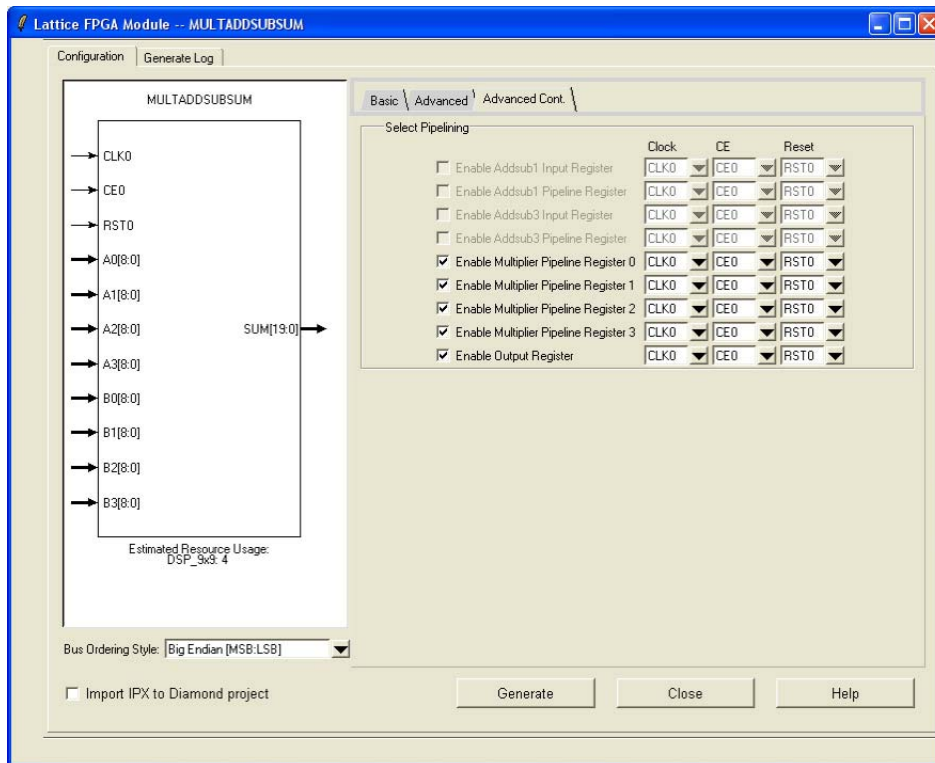


Figure 14-10. MULTADDSUBSUM Mode Advanced



Targeting the sysDSP Block by Inference

The Inferencing flow enables the design tools to infer sysDSP Blocks from a HDL design. It is important to note that when using the Inferencing flow, unless the code style matches the sysDSP Block, results will not be optimal. Consider the following Verilog and VHDL examples:

```
// This Verilog example will be mapped into single MULT18X18MACB with the output register enabled
module mult_acc (dataout, dataax, dataay, clk);
    output [16:0] dataout;
    input [7:0] dataax, dataay;
    input clk;
    reg [16:0] dataout;

    wire [15:0] mult_a = dataax * dataay; // 9x9 Multiplier
    wire [16:0] adder_out;
    assign adder_out = mult_a + dataout; // Accumulator
    always @(posedge clk)
    begin
        dataout <= adder_out; // Output Register of the Accumulator
    end
endmodule
```

```
-- This VHDL example will be mapped into single MULT18X18MACB with all the registers enabled
library ieee;
use ieee.std_logic_1164.all;
use ieee.std_logic_unsigned.all;
```

```
entity mac is
port (clk, reset : in std_logic;
      dataax, dataay : in std_logic_vector(8 downto 0);
      dataout : out std_logic_vector(17 downto 0));
end;
```

```
architecture arch of mac is
signal dataax_reg, dataay_reg : std_logic_vector(8 downto 0);
signal multout, multout_reg : std_logic_vector(17 downto 0);
signal addout : std_logic_vector(17 downto 0);
signal dataout_reg : std_logic_vector(17 downto 0);
begin
```

```
dataout <= dataout_reg;
```

```
process (clk, reset)
begin
if (reset = '1') then
    dataax_reg <= (others => '0');
    dataay_reg <= (others => '0');
elseif (clk'event and clk='1') then
    dataax_reg <= dataax;
    dataay_reg <= dataay;
end if;
end process;
```

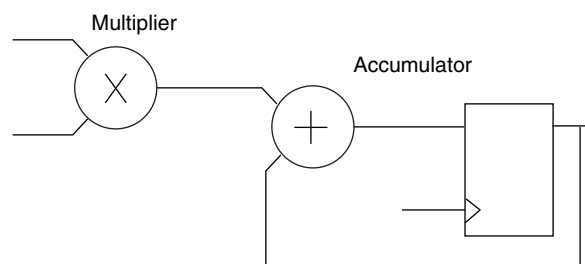
```
multout <= dataax_reg * dataay_reg;
```

```
process (clk, reset)
begin
if (reset = '1') then
    multout_reg <= (others => '0');
elseif (clk'event and clk='1') then
    multout_reg <= multout;
end if;
```

```
end process;  
  
addout <= multout_reg + dataout_reg;  
  
process (clk, reset)  
begin  
if (reset = '1') then  
    dataout_reg <= (others => '0');  
elsif (clk'event and clk='1') then  
    dataout_reg <= addout;  
end if;  
end process;  
end arch;
```

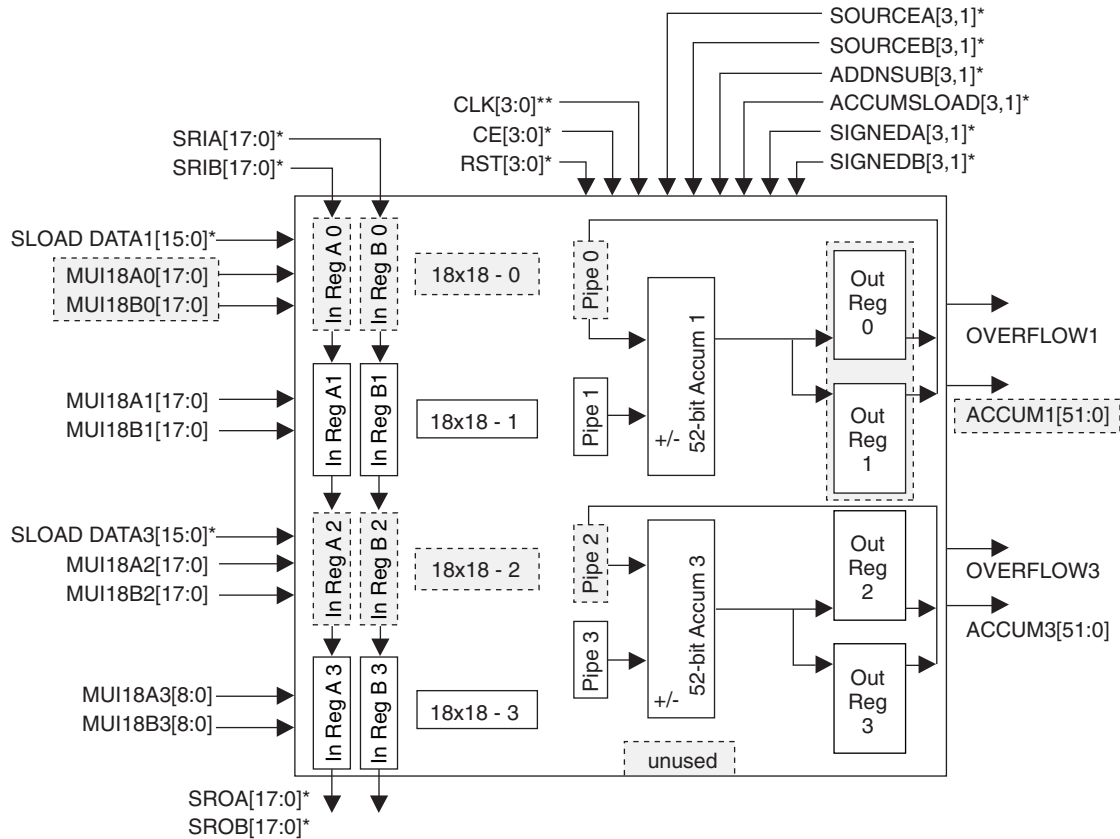
The above RTL will infer the following block diagram:

Figure 14-11. MULT18X18MACB Block Diagram



This block diagram can be mapped directly into the sysDSP primitives. Note that if a test point were added between the multiplier and the accumulator, or two output registers, etc. the code could not be mapped into a MULT18X18MACB of a sysDSP Block. Therefore, options that could be included in a design are input registers, pipeline registers, etc.

Figure 14-12. MAC18X18MACB Packed into a sysDSP Block



Notes:
 *These signals are optional.
 **At least one clock is required.

sysDSP Blocks in the Report File

To check the configuration of the sysDSP Blocks in your design you can look at the MAP and Place & Route (PAR) report files. The MAP report file shows the mapped sysDSP components/primitives in your design. The Place & Route (PAR) report file shows the number of components in each sysDSP Block. The report files that follow show how the inferred MAC was used.

MAP Report File

```
. MULT18X18MACB addout_17_0:
```

Multiplier

| Operation | Unsigned | | |
|---------------------|----------|----|-----|
| Operation Registers | CLK | CE | RST |
| ----- | | | |
| Input | | | |
| Pipeline | | | |
| Operation Registers | CLK | CE | RST |
| ----- | | | |
| Input | | | |
| Pipeline | | | |

```

AddSub
  Operation
  Operation Registers      Add
                           CLK   CE   RST
  -----
      Input
      Pipeline
Data
  Input Registers         CLK   CE   RST
  -----
      A                   CLK0  CE0  RST0
      B                   CLK0  CE0  RST0
  Pipeline Registers     CLK   CE   RST
  -----
      Pipe                CLK0  CE0  RST0
  Output Register        CLK   CE   RST
  -----
      Output              CLK0  CE0  RST0

Other
  GSR      ENABLED
Number Of Mapped DSP Components:
-----
MULT36X36B      0
MULT18X18B      0
MULT18X18MACB   1
MULT18X18ADDSUBB 0
MULT18X18ADDSUBSUMB 0
MULT9X9B        0
MULT9X9ADDSUBB  0
MULT9X9ADDSUBSUMB 0
-----

```

Place & Route (PAR) Report File

```

DSP Utilization Summary:
DSP Block #: 1   2   3   4   5   6   7   8   9   10  11  12  13  14  15  16  17  18
# of MULT36X36B
# of MULT18X18B
# of MULT18X18MACB
# of MULT18X18ADDSUBB
# of MULT18X18ADDSUBSUMB
# of MULT9X9B
# of MULT9X9ADDSUBB
# of MULT9X9ADDSUBSUMB
DSP Block 1   Component_Type      Instance_Name
DSP Block 2   Component_Type      Instance_Name
DSP Block 3   Component_Type      Instance_Name
DSP Block 4   Component_Type      Instance_Name
DSP Block 5   Component_Type      Instance_Name
DSP Block 6   Component_Type      Instance_Name
DSP Block 7   Component_Type      Instance_Name
DSP Block 8   Component_Type      Instance_Name
DSP Block 9   Component_Type      Instance_Name
R45C81       MULT18X18MACB      addout_17_0
DSP Block 10  Component_Type      Instance_Name
DSP Block 11  Component_Type      Instance_Name
DSP Block 12  Component_Type      Instance_Name
DSP Block 13  Component_Type      Instance_Name
DSP Block 14  Component_Type      Instance_Name
DSP Block 15  Component_Type      Instance_Name
DSP Block 16  Component_Type      Instance_Name
DSP Block 17  Component_Type      Instance_Name
DSP Block 18  Component_Type      Instance_Name

```

Targeting the sysDSP Block Using Simulink

Simulink Overview

Simulink is a graphical add-on (similar to schematic entry) for Matlab®, which is produced by The MathWorks. For more information, refer to the Simulink web page at www.mathworks.com/products/simulink/.

Why is Simulink used?

- It allows users to create algorithms using floating point numbers.
- It helps users convert floating point algorithms into fixed point algorithms.

How does Simulink fit into the normal ispLEVER or Diamond design/process flow?

- Once you have converted have your algorithm working in fixed point. You can use the Lattice ispDSP block to create HDL files, which can be instantiated in your HDL design.

What does Lattice provide?

- Lattice provides a library of blocks for the Simulink tool, which include Multipliers, Adders, Registers, and other standard building blocks. Besides the basic building blocks there are a couple unique Lattice blocks:

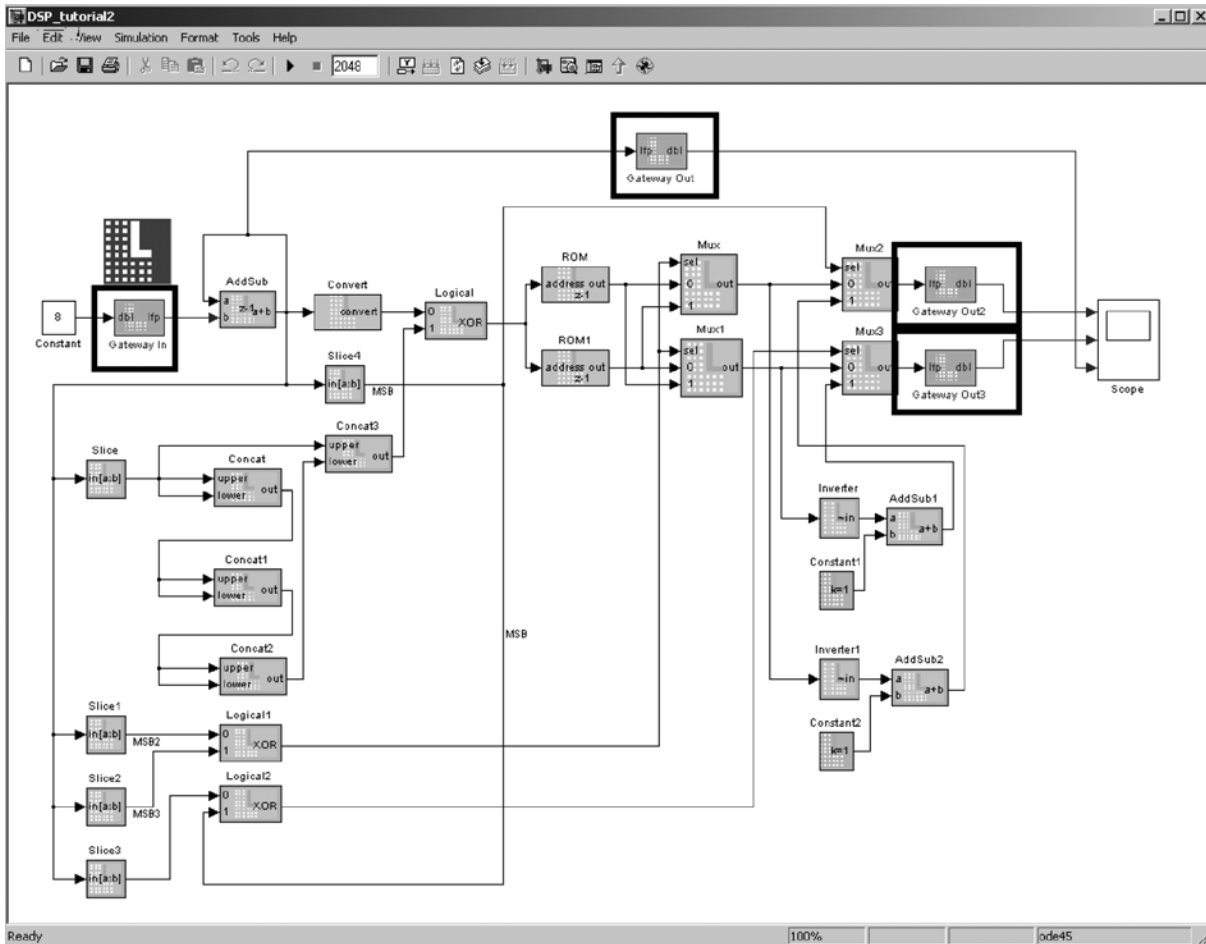
Gateways In and Out

Everything between Gateways In and Out represents the HDL code. Everything before a Gateway In is the stimulus your test bench. Everything after the Gateway Out are the signals you will be monitoring in the test bench. Below is an example. The box on the left contains Gateway In blocks and the three boxes on the right contain Gateway Out blocks in Figure 14-13.

Generate

The Generate block is used to convert Fixed point Simulink design into HDL files which can be instantiated in a HDL design. The Generate block is identified by the Lattice logo and can be seen in Figure 14-13.

Figure 14-13. Simulink Design



Targeting the sysDSP Block by Instantiating Primitives

The sysDSP Block can be targeted by instantiating the sysDSP Block primitives into the design. The advantage of instantiating primitives is that it provides access to all ports and sets all available parameters. The disadvantage of this flow is that all this customization requires extra coding by the user. Appendix A details the syntax for the sysDSP Block primitives.

sysDSP Block Control Signal and Data Signal Descriptions

| | |
|------------|---|
| RST | Asynchronous reset of selected registers |
| CE | Clock Enable 1 = enabled, 0 = disabled |
| SIGNEDA | Dynamic signal: 0 = unsigned, 1 = signed |
| SIGNEDB | Dynamic signal: 0 = unsigned, 1 = signed |
| ACCUMSLOAD | Dynamic signal: 0 = accumulate, 1 = load |
| ADDNSUB | Dynamic signal: 0 = subtract, 1 = add |
| SOURCEA | Dynamic signal: 0 = parallel input, 1 = shift input |
| SOURCEB | Dynamic signal: 0 = parallel input, 1 = shift input |

Technical Support Assistance

Hotline: 1-800-LATTICE (North America)
+1-503-268-8001 (Outside North America)

e-mail: techsupport@latticesemi.com

Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|---|
| February 2006 | 01.0 | Initial release. |
| September 2006 | 01.1 | Updated table 1 with new software numbers. |
| | | Updated figure 1 summation size from 37 to 38 |
| November 2008 | 01.2 | Updated sysDSP Block Control Signal and Data Signal Descriptions. |
| June 2010 | 01.3 | Updated for Lattice Diamond design software support. |

Appendix A. DSP Block Primitives

MULT18X18B

```

input A17,A16,A15,A14,A13,A12,A11,A10,A9,A8,A7,A6,A5,A4,A3,A2,A1,A0;
input B17,B16,B15,B14,B13,B12,B11,B10,B9,B8,B7,B6,B5,B4,B3,B2,B1,B0;
input SIGNEDA, SIGNEDB, SOURCEA, SOURCEB;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input SRIA17,SRIA16,SRIA15,SRIA14,SRIA13,SRIA12,SRIA11,SRIA10,SRIA9;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB17,SRIB16,SRIB15,SRIB14,SRIB13,SRIB12,SRIB11,SRIB10,SRIB9;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA17,SROA16,SROA15,SROA14,SROA13,SROA12,SROA11,SROA10,SROA9;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB17,SROB16,SROB15,SROB14,SROB13,SROB12,SROB11,SROB10,SROB9;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output P35,P34,P33,P32,P31,P30,P29,P28,P27,P26,P25,P24,P23,P22,P21,P20,P19,P18;
output P17,P16,P15,P14,P13,P12,P11,P10,P9,P8,P7,P6,P5,P4,P3,P2,P1,P0;
parameter REG_INPUTA_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";

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MULT18X18ADDSUBB

```

input A017,A016,A015,A014,A013,A012,A011,A010,A09;
input A08,A07,A06,A05,A04,A03,A02,A01,A00;
input A117,A116,A115,A114,A113,A112,A111,A110,A19;
input A18,A17,A16,A15,A14,A13,A12,A11,A10;
input B017,B016,B015,B014,B013,B012,B011,B010,B09;
input B08,B07,B06,B05,B04,B03,B02,B01,B00;
input B117,B116,B115,B114,B113,B112,B111,B110,B19;
input B18,B17,B16,B15,B14,B13,B12,B11,B10;
input SIGNEDA, SIGNEDB, SOURCEA0, SOURCEA1, SOURCEB0, SOURCEB1, ADDNSUB;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input SRIA17,SRIA16,SRIA15,SRIA14,SRIA13,SRIA12,SRIA11,SRIA10,SRIA9;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB17,SRIB16,SRIB15,SRIB14,SRIB13,SRIB12,SRIB11,SRIB10,SRIB9;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA17,SROA16,SROA15,SROA14,SROA13,SROA12,SROA11,SROA10,SROA9;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB17,SROB16,SROB15,SROB14,SROB13,SROB12,SROB11,SROB10,SROB9;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output
SUM36,SUM35,SUM34,SUM33,SUM32,SUM31,SUM30,SUM29,SUM28,SUM27,SUM26,SUM25,SUM24,SUM23,SUM22,SUM21,SU
M20,SUM19,SUM18,SUM17,SUM16,SUM15,SUM14,SUM13,SUM12,SUM11,SUM10,SUM9,SUM8,SUM7,SUM6,SUM5,SUM4,SUM3
,SUM2,SUM1,SUM0;

```

```

parameter REG_INPUTA0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";

```

MULT18X18ADDSUBSUMB

```

input A017,A016,A015,A014,A013,A012,A011,A010,A09;
input A08,A07,A06,A05,A04,A03,A02,A01,A00;
input A117,A116,A115,A114,A113,A112,A111,A110,A19;
input A18,A17,A16,A15,A14,A13,A12,A11,A10;
input A217,A216,A215,A214,A213,A212,A211,A210,A29;
input A28,A27,A26,A25,A24,A23,A22,A21,A20;
input A317,A316,A315,A314,A313,A312,A311,A310,A39;
input A38,A37,A36,A35,A34,A33,A32,A31,A30;
input B017,B016,B015,B014,B013,B012,B011,B010,B09;
input B08,B07,B06,B05,B04,B03,B02,B01,B00;
input B117,B116,B115,B114,B113,B112,B111,B110,B19;
input B18,B17,B16,B15,B14,B13,B12,B11,B10;
input B217,B216,B215,B214,B213,B212,B211,B210,B29;
input B28,B27,B26,B25,B24,B23,B22,B21,B20;
input B317,B316,B315,B314,B313,B312,B311,B310,B39;
input B38,B37,B36,B35,B34,B33,B32,B31,B30;
input SIGNEDA, SIGNEDB, ADDNSUB1, ADDNSUB3;
input SOURCEA0, SOURCEA1, SOURCEA2, SOURCEA3;
input SOURCEB0, SOURCEB1, SOURCEB2, SOURCEB3;

```

```

input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input SRIA17,SRIA16,SRIA15,SRIA14,SRIA13,SRIA12,SRIA11,SRIA10,SRIA9;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB17,SRIB16,SRIB15,SRIB14,SRIB13,SRIB12,SRIB11,SRIB10,SRIB9;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA17,SROA16,SROA15,SROA14,SROA13,SROA12,SROA11,SROA10,SROA9;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB17,SROB16,SROB15,SROB14,SROB13,SROB12,SROB11,SROB10,SROB9;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output
SUM37,SUM36,SUM35,SUM34,SUM33,SUM32,SUM31,SUM30,SUM29,SUM28,SUM27,SUM26,SUM25,SUM24,SUM23,SUM22,SU
M21,SUM20,SUM19,SUM18,SUM17,SUM16,SUM15,SUM14,SUM13,SUM12,SUM11,SUM10,SUM9,SUM8,SUM7,SUM6,SUM5,SUM
4,SUM3,SUM2,SUM1,SUM0;
parameter REG_INPUTA0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA2_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA2_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA2_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA3_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA3_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA3_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB2_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB2_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB2_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB3_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB3_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB3_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE2_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE2_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE2_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE3_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE3_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE3_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_0_RST = " RST0, RST1, RST2, RST3 ";

```

```
parameter REG_SIGNEDB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB1_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB1_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB1_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB1_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB1_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB1_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB3_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB3_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB3_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB3_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB3_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB3_1_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";
```

MULT18X18MACB

```
input A17,A16,A15,A14,A13,A12,A11,A10,A9;
input A8,A7,A6,A5,A4,A3,A2,A1,A0;
input B17,B16,B15,B14,B13,B12,B11,B10,B9;
input B8,B7,B6,B5,B4,B3,B2,B1,B0;
input ADDNSUB, SIGNEDA, SIGNEDB,ACCUMSLOAD;
input SOURCEA, SOURCEB;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input LD51, LD50, LD49, LD48, LD47, LD46, LD45, LD44, LD43, LD42, LD41, LD40
input LD39, LD38, LD37, LD36, LD35, LD34, LD33, LD32, LD31, LD30
input LD29, LD28, LD27, LD26, LD25, LD24, LD23, LD22, LD21, LD20
input LD19, LD18, LD17, LD16, LD15, LD14, LD13, LD12, LD11, LD10
input LD9, LD8, LD7, LD6, LD5, LD4, LD3, LD2, LD1, LD0;
input SRIA17,SRIA16,SRIA15,SRIA14,SRIA13,SRIA12,SRIA11,SRIA10,SRIA9;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB17,SRIB16,SRIB15,SRIB14,SRIB13,SRIB12,SRIB11,SRIB10,SRIB9;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA17,SROA16,SROA15,SROA14,SROA13,SROA12,SROA11,SROA10,SROA9;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB17,SROB16,SROB15,SROB14,SROB13,SROB12,SROB11,SROB10,SROB9;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output
ACCUM51,ACCUM50,ACCUM49,ACCUM48,ACCUM47,ACCUM46,ACCUM45,ACCUM44,ACCUM43,ACCUM42,ACCUM41,ACCUM40,AC
CUM39,ACCUM38,ACCUM37,ACCUM36,ACCUM35,ACCUM34,ACCUM33,ACCUM32,ACCUM31,ACCUM30,ACCUM29,ACCUM28,ACCU
M27,ACCUM26,ACCUM25,ACCUM24,ACCUM23,ACCUM22,ACCUM21,ACCUM20,ACCUM19,ACCUM18,ACCUM17,ACCUM16,ACCUM1
5,ACCUM14,ACCUM13,ACCUM12,ACCUM11,ACCUM10,ACCUM9,ACCUM8,ACCUM7,ACCUM6,ACCUM5,ACCUM4,ACCUM3,ACCUM2,
ACCUM1,ACCUM0,OVERFLOW;
parameter REG_INPUTA_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_1_CE = " CE0, CE1, CE2, CE3 ";
```

```
parameter REG_SIGNEDA_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ACCUMSLOAD_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ACCUMSLOAD_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ACCUMSLOAD_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ACCUMSLOAD_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ACCUMSLOAD_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ACCUMSLOAD_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";
```

MULT36X36B

```
input A35,A34,A33,A32,A31,A30,A29,A28,A27,A26,A25,A24,A23,A22,A21,A20,A19,A18;
input A17,A16,A15,A14,A13,A12,A11,A10,A9,A8,A7,A6,A5,A4,A3,A2,A1,A0;
input B35,B34,B33,B32,B31,B30,B29,B28,B27,B26,B25,B24,B23,B22,B21,B20,B19,B18;
input B17,B16,B15,B14,B13,B12,B11,B10,B9,B8,B7,B6,B5,B4,B3,B2,B1,B0;
input SIGNEDA, SIGNEDB;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
output P71,P70,P69,P68,P67,P66,P65,P64,P63,P62,P61,P60,P59,P58,P57,P56,P55,P54;
output P53,P52,P51,P50,P49,P48,P47,P46,P45,P44,P43,P42,P41,P40,P39,P38,P37,P36;
output P35,P34,P33,P32,P31,P30,P29,P28,P27,P26,P25,P24,P23,P22,P21,P20,P19,P18;
output P17,P16,P15,P14,P13,P12,P11,P10,P9,P8,P7,P6,P5,P4,P3,P2,P1,P0;
parameter REG_INPUTA_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";
```

MULT9X9B

```

input A8,A7,A6,A5,A4,A3,A2,A1,A0;
input B8,B7,B6,B5,B4,B3,B2,B1,B0;
input SIGNEDA, SIGNEDB, SOURCEA, SOURCEB;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output P17,P16,P15,P14,P13,P12,P11,P10,P9,P8,P7,P6,P5,P4,P3,P2,P1,P0;
parameter REG_INPUTA_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";

```

MULT9X9ADDSUBB

```

input A08,A07,A06,A05,A04,A03,A02,A01,A00;
input A18,A17,A16,A15,A14,A13,A12,A11,A10;
input B08,B07,B06,B05,B04,B03,B02,B01,B00;
input B18,B17,B16,B15,B14,B13,B12,B11,B10;
input SIGNEDA, SIGNEDB, ADDNSUB;
input SOURCEA0, SOURCEA1, SOURCEB0, SOURCEB1;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output
SUM18,SUM17,SUM16,SUM15,SUM14,SUM13,SUM12,SUM11,SUM10,SUM9,SUM8,SUM7,SUM6,SUM5,SUM4,SUM3,SUM2,SUM1
,SUM0;
parameter REG_INPUTA0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE0_RST = " RST0, RST1, RST2, RST3 ";

```

```
parameter REG_PIPELINE1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";
```

MULT9X9ADDSUBSUMB

```
input A08,A07,A06,A05,A04,A03,A02,A01,A00;
input A18,A17,A16,A15,A14,A13,A12,A11,A10;
input A28,A27,A26,A25,A24,A23,A22,A21,A20;
input A38,A37,A36,A35,A34,A33,A32,A31,A30;
input B08,B07,B06,B05,B04,B03,B02,B01,B00;
input B18,B17,B16,B15,B14,B13,B12,B11,B10;
input B28,B27,B26,B25,B24,B23,B22,B21,B20;
input B38,B37,B36,B35,B34,B33,B32,B31,B30;
input SIGNEDA, SIGNEDB,ADDNSUB1,ADDNSUB3;
input SOURCEA0, SOURCEA1, SOURCEA2, SOURCEA3;
input SOURCEB0, SOURCEB1, SOURCEB2, SOURCEB3;
input CE0,CE1,CE2,CE3,CLK0,CLK1,CLK2,CLK3,RST0,RST1,RST2,RST3;
input SRIA8,SRIA7,SRIA6,SRIA5,SRIA4,SRIA3,SRIA2,SRIA1,SRIA0;
input SRIB8,SRIB7,SRIB6,SRIB5,SRIB4,SRIB3,SRIB2,SRIB1,SRIB0;
output SROA8,SROA7,SROA6,SROA5,SROA4,SROA3,SROA2,SROA1,SROA0;
output SROB8,SROB7,SROB6,SROB5,SROB4,SROB3,SROB2,SROB1,SROB0;
output
SUM19,SUM18,SUM17,SUM16,SUM15,SUM14,SUM13,SUM12,SUM11,SUM10,SUM9,SUM8,SUM7,SUM6,SUM5,SUM4,SUM3,SUM
2,SUM1,SUM0;
parameter REG_INPUTA0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA2_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA2_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA2_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTA3_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTA3_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTA3_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB0_RST = " RST0, RST1, RST2, RST3 ";
```



```

parameter REG_INPUTB1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB2_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB2_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB2_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_INPUTB3_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_INPUTB3_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_INPUTB3_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE2_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE2_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE2_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_PIPELINE3_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_PIPELINE3_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_PIPELINE3_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_OUTPUT_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_OUTPUT_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_OUTPUT_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDA_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDA_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDA_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_SIGNEDB_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_SIGNEDB_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_SIGNEDB_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB1_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB1_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB1_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB1_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB1_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB1_1_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB3_0_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB3_0_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB3_0_RST = " RST0, RST1, RST2, RST3 ";
parameter REG_ADDNSUB3_1_CLK = " NONE, CLK0, CLK1, CLK2, CLK3 ";
parameter REG_ADDNSUB3_1_CE = " CE0, CE1, CE2, CE3 ";
parameter REG_ADDNSUB3_1_RST = " RST0, RST1, RST2, RST3 ";
parameter GSR = " Enabled, Disabled ";

```

Appendix B. Using IPexpress for Diamond

Invoking IPexpress for Diamond

There are several ways IPexpress can be invoked. To invoke IPexpress from the Start menu, select:

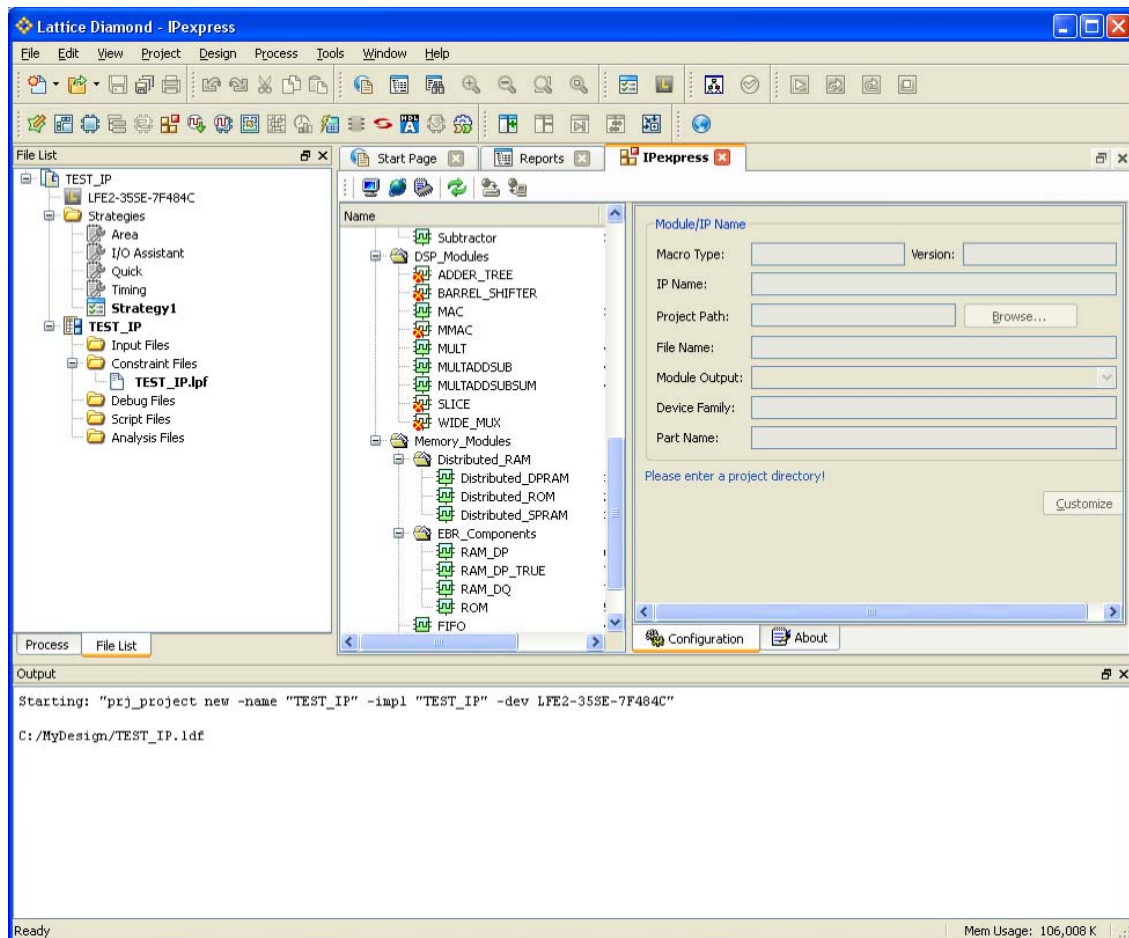
Start > Programs > Lattice Diamond 1.0 > Accessories > IPexpress

To invoke IPexpress from within Diamond, a project must be opened, then invoke the IPexpress icon or select:

Tools > IPexpress

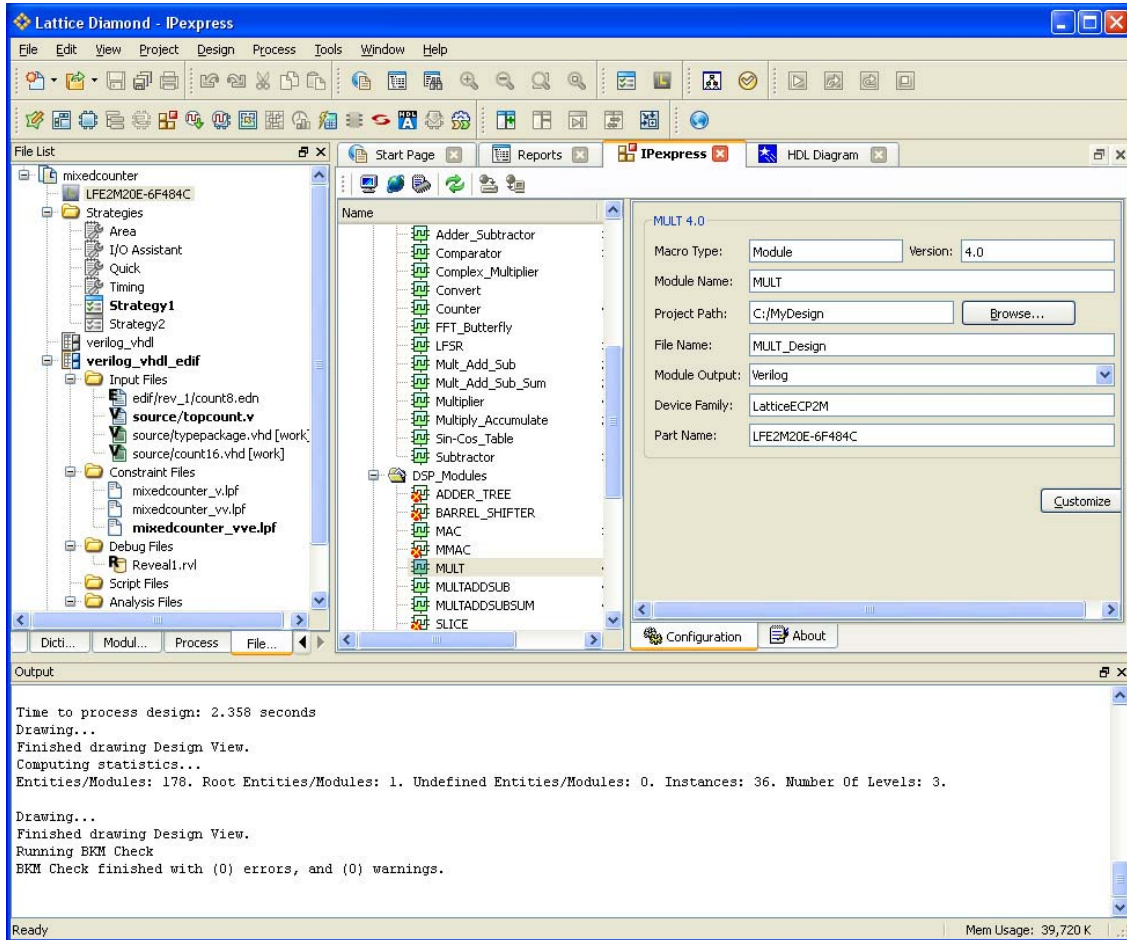
The IPexpress interface appears as shown in Figure 14-14.

Figure 14-14. IPexpress Interface



Scroll to the modules and left-click on the module you wish to use. Enter the information into the IPexpress interface as shown in the example Figure 14-15.

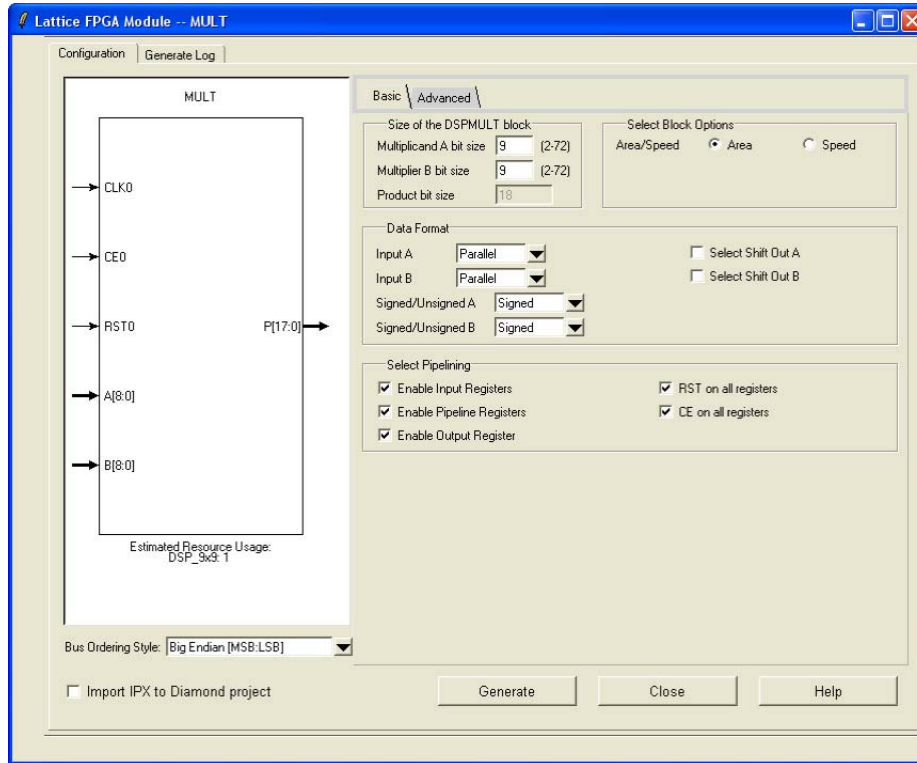
Figure 14-15. Creating the Module Instance



Select **Customize**.

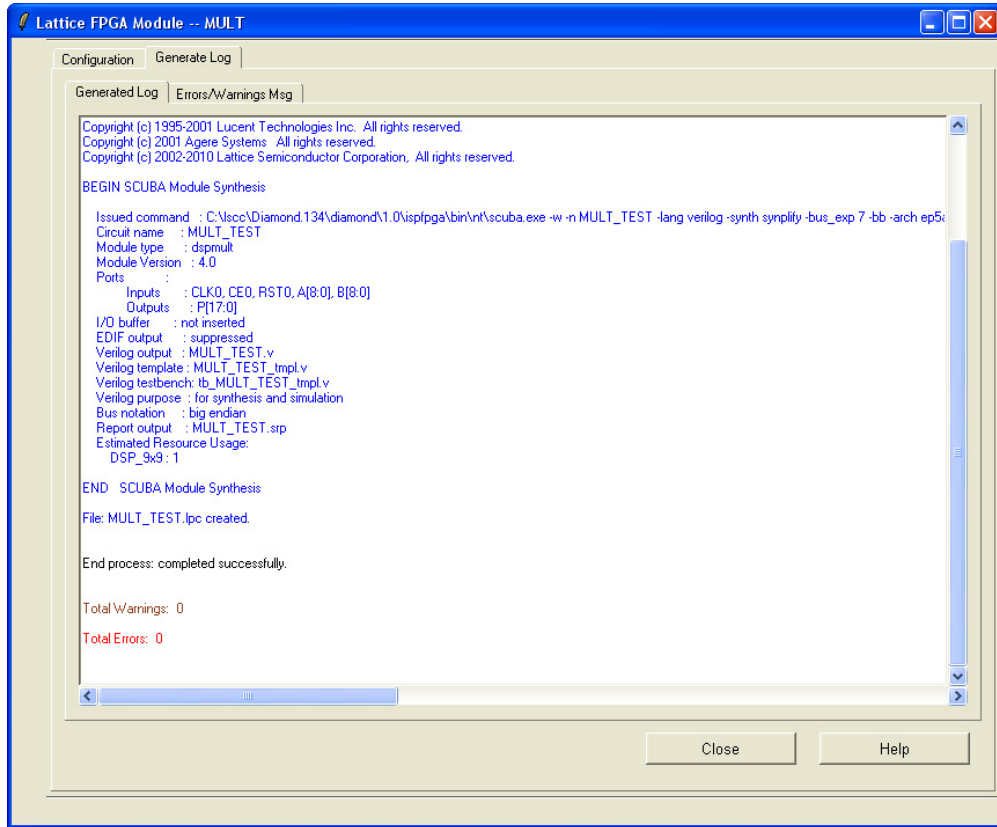
An example of a MULT Module Dialog window appears as shown in Figure 14-16. Select **Help** for information about the fields in this window.

Figure 14-16. MULT Mode Basic Set-up



When you are finished selecting your options, select **Generate**. A log window will appear similar to what is shown in Figure 14-17.

Figure 14-17. IP Generation Log Window



Introduction

The configuration memory in the LatticeECP2™ and LatticeECP2M™ FPGAs is built using volatile SRAM; therefore, an external non-volatile configuration memory is required to maintain the configuration data when the power is removed. This non-volatile memory supplies the configuration data to the LatticeECP2/M when it powers-up, or any other time the device needs to be updated.

To support multiple configuration options the LatticeECP2/M supports the Lattice sysCONFIG™ interface, as well as the dedicated ispJTAG™ port. The available configuration options, or ports, are listed in Table 15-1.

Table 15-1. Supported Configuration Ports

| Interface | Port |
|-----------|--|
| sysCONFIG | SPI |
| | SPIm |
| | Slave Serial |
| | Slave Parallel |
| ispJTAG | JTAG (IEEE 1149.1 and IEEE 1532 compliant) |

This technical note covers all of the configuration options available for LatticeECP2/M.

General Configuration Flow

The LatticeECP2/M will enter configuration mode when one of three things happens, power is applied to the chip, the PROGRAMN pin is driven low, or when a JTAG Refresh instruction is issued. Upon entering configuration mode the INITN pin and the DONE pin are driven low to indicate that the device is initializing, i.e. getting ready to receive configuration data.

Once the LatticeECP2/M has finished initializing, the INITN pin will be driven high. The low to high transition of the INITN pin causes the CFG pins to be sampled, telling the LatticeECP2/M which port it is going to configure from. The LatticeECP2/M then begins reading data from the selected port and starts looking for the preamble, BDB3 (hex). All data after the preamble is valid configuration data.

When the LatticeECP2/M has finished reading all of the configuration data, assuming there have been no errors, the DONE pin goes high and the LatticeECP2/M enters user mode, in other words the device begins to function according to the user's design.

Note that the LatticeECP2/M may also be programmed via JTAG. When programming via JTAG, the INITN and DONE signals have no meaning, because JTAG, per the IEEE standard, takes complete control of the chip and it's I/Os.

The Lattice ECP2/M devices are also available in an "S" version which supports the use of an encrypted bitstream configuration file. These versions have the same configuration options as the standard versions, except where noted in this document. When using these devices, the user should refer to the [LatticeECP2/M Family Data Sheet](#) and TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#), in addition to this document, to understand the configuration requirements.

The following sections define each configuration pin, each configuration mode, and all of the configuration options for the LatticeECP2/M.

Configuration Pins

The LatticeECP2/M supports two types of configuration pins, dedicated and dual-purpose. The dedicated pins are used exclusively for configuration; the dual-purpose pins, when not being used for configuration, are available as extra I/O pins. If a dual-purpose pin is to be used both for configuration and as a general purpose I/O (GPIO) the user must adhere to the following:

- The I/O type must remain the same, in other words if the pin is a 3.3V CMOS pin (LVCMOS33) during configuration it must remain a 3.3V CMOS pin as a GPIO.
- The user must select the correct CONFIG_MODE setting and set the PERSISTENT bit to OFF in order to use the dual-purpose sysCONFIG pins as GPIO after configuration. In ispLEVER® these preferences can be set in the Design Planner. If you are using Lattice Diamond™ design software, select **Tools > Spreadsheet View** and then select the **Global Preferences** tab in the Spreadsheet View.
- The user is responsible for insuring that no internal or external logic will interfere with device configuration.

Also, if slave parallel configuration mode is not being used then one or both of the parallel port chip selects (CSN, CS1N) must be high or tri-state during configuration.

Programmable options control the direction and type of each dual-purpose configuration pin. These options are controlled via pin preferences in Lattice ispLEVER and Diamond software, or as HDL source file attributes.

The LatticeECP2/M also supports ispJTAG for configuration, transparent read back, and JTAG testing. The following sections describe the function of the various sysCONFIG and JTAG pins. Table 15-2 is provided for reference.

Table 15-2. Configuration Pins for the LatticeECP2/M

| Pin Name | I/O Type | Pin Type | Mode Used |
|----------------------------|--|--------------|-----------------------|
| CFG[2:0] | Input, weak pull-up | Dedicated | All |
| PROGRAMN | Input, weak pull-up | Dedicated | All |
| INITN | Bi-Directional Open Drain, weak pull-up | Dedicated | All |
| DONE | Bi-Directional Open Drain with weak pull-up, or Active Drive | Dedicated | All |
| CCLK | Input or Output | Dedicated | All |
| DI/CSSPION ² | Input, weak pull up | Dual-Purpose | Serial, SPI, SPIm |
| DOU/CSON ² | Output | Dual-Purpose | Parallel, Serial, SPI |
| CSN ² | Input, weak pull-up | Dual-Purpose | Parallel |
| CS1N ² | Input, weak pull-up | Dual-Purpose | Parallel |
| WRITEN ² | Input, weak pull-up | Dual-Purpose | Parallel |
| BUSY/SISPI ² | Output, tri-state, weak pull-up | Dual-Purpose | Serial, SPI, SPIm |
| D[0]/SPIFASTN ² | Input or Output | Dual-Purpose | Parallel, SPI, SPIm |
| D[1:6] ² | | | Parallel |
| D[7]/SPID0 ² | | | Parallel, SPI, SPIm |
| TDI | Input, weak pull-up | Dedicated | JTAG |
| TDO | Output, weak pull-up | Dedicated | JTAG |
| TCK | Input with Hysteresis | Dedicated | JTAG |
| TMS | Input, weak pull-up | Dedicated | JTAG |

1. Weak pull-ups consist of a current source of 30μA to 150μA. The pull-ups for sysCONFIG dedicated and dual-purpose pins track V_{CCIOB}; the pull-ups for TDI, TDO, and TMS track V_{CCJ}.
2. The sysCONFIG pins on the LatticeECP2M50/M70/M100 are dedicated sysCONFIG pins. The sysCONFIG output pins are actively driven during normal device operation.

Dedicated Control Pins

The following sub-sections describe the LatticeECP2/M dedicated sysCONFIG pins. These pins are powered by V_{CCIO8} .

While the device is under IEEE 1149.1 or 1532 JTAG control the dedicated programming pins have no meaning. This is because a boundary scan cell will control each pin, per JTAG 1149.1, rather than normal internal logic.

CFG[2:0]

The Configuration Mode pins, CFG[2:0], are dedicated inputs with weak pull-ups. The CFG pins are sampled on the rising edge of INITN and are used to select the configuration mode, i.e. what type of device the LatticeECP2/M will configure from. As a consequence the CFG pins determine which groups of dual-purpose pins will be used for device configuration (see the right-most column in Table 15-2). See Table 15-3 for a list of Configuration Modes.

Table 15-3. Configuration Modes

| Configuration Mode | | CFG[2] | CFG[1] | CFG[0] | D[0]/SPIFASTN |
|--------------------|---------------|--------|--------|--------|---------------|
| SPI | Normal (0x03) | 0 | 0 | 0 | Pull-Up |
| | Fast (0x0B) | 0 | 0 | 0 | Pull-Down |
| Reserved | | 0 | 0 | 1 | X |
| SPIm | Normal (0x03) | 0 | 1 | 0 | Pull-Up |
| | Fast (0x0B) | 0 | 1 | 0 | Pull-Down |
| Reserved | | 0 | 1 | 1 | X |
| Reserved | | 1 | 0 | 0 | X |
| Slave Serial | | 1 | 0 | 1 | X |
| Reserved | | 1 | 1 | 0 | X |
| Slave Parallel | | 1 | 1 | 1 | D0 |

Notes:

JTAG is always available for IEEE 1149.1 and 1532 support.

PROGRAMN

The PROGRAMN pin is a dedicated input with a weak pull-up. This pin is used to initiate a non-JTAG SRAM configuration sequence.

A high to low signal applied to PROGRAMN takes the device out of user mode and sets it into configuration mode. The low to high transition will initiate the configuration process. The PROGRAMN pin can be used to trigger configuration at any time.

INITN

The INITN pin is a bidirectional open drain control pin. INITN is capable of driving a low pulse out as well as detecting a low pulse driven in.

When the PROGRAMN pin is driven low, or a JTAG Reset instruction is received, or after the internal Power-On-Reset signal is released during power-up, the INITN pin will be driven low to reset the internal configuration circuitry. Once the PROGRAMN pin is driven high, the configuration initialization begins. Once the configuration initialization is completed, the INITN pin will go high. To delay configuration the INITN pin can be held low externally. The device will not enter configuration mode as long as the INITN pin is held low. A low to high transition on INITN causes the CFG pins to be sampled, telling the LatticeECP2/M which port to use, and starts configuration.

During configuration the INITN pin becomes an error detection pin. If a CRC error is detected during configuration INITN will be driven low. The error will be cleared at the beginning of the next configuration.

DONE

The DONE pin is a dedicated bi-directional open drain with a weak pull-up (default), or it is an actively driven pin.

DONE goes low when INITN goes low, when INITN and PROGRAMN go high, and the internal Done bit is programmed at the end of configuration, the DONE pin will be released (or driven high, if it is an actively driven pin). The DONE pin can be held low externally and, depending on the wake-up sequence selected, the device will not become functional until the DONE pin is externally brought high. Externally delaying the wake-up sequence using the DONE pin is a good way to synchronize the wake-up of multiple FPGAs; it is also required when configuring multiple FPGAs from a single configuration device.

Sampling the DONE pin is a good way for an external device to tell if the FPGA has finished configuration. However, when using IEEE 1532 JTAG to configure SRAM the DONE pin is driven by a boundary scan cell, so the state of the DONE pin has no meaning during IEEE 1532 JTAG configuration (once configuration is complete, DONE reverts to internal logic and will be high).

CCLK

CCLK is a dedicated bi-directional pin; direction depends on whether a Master or Slave mode is selected. If a Master mode (SPI or SPIm) is selected, via the CFG pins, the CCLK pin becomes an output; otherwise CCLK is an input.

If the CCLK pin becomes an output, the internal programmable oscillator is connected to CCLK and is driven out to slave devices. CCLK will stop 120 clock cycles after the DONE pin is brought high. The extra clock cycles ensure that enough clocks are provided to wake-up other devices in the chain. When stopped, CCLK becomes an input (tri-stated output). CCLK will restart (become an output again) on the next configuration initialization sequence.

The MCCLK_FREQ parameter (one of the global preferences in the Design Planner of ispLEVER or the Spreadsheet View in Diamond) controls the CCLK master frequency (see data sheet On-Chip Oscillator section for the frequency selection). The software default setting for the configuration CCLK is 2.5 MHz. For a complete list of the supported Master Clock frequencies, please see the [LatticeECP2/M Family Data Sheet](#). One of the first operations during configuration is the MCCLK_FREQ parameter; once this parameter is loaded the frequency changes to the selected value. Care should be exercised not to exceed the frequency specification of the slave devices or the signal integrity capabilities of the PCB layout.

When downloading an encrypted bitstream file to the LatticeECP2/M S-Series devices, the user must adhere to the appropriate conditions for the CCLK signal. These conditions are shown in TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#).

Dual-Purpose sysCONFIG Pins

The following is a list of the dual-purpose sysCONFIG pins. If any of these pins are used for configuration and for user I/O, the user must adhere to the requirements listed at the start of the Configuration pin sections. On LatticeECP2M50/M70/M100 devices, the sysCONFIG pins described below are dedicated pins. When using the same pins to access the external boot Flash, the system design must take care of tri-stating these output pins while driving these pins from a different I/O pin.

These pins are powered by V_{CCIO8} .

DI/CSSPI0N

The DI/CSSPI0N dual-purpose pin is designated as DI (Data Input) for Serial configurations. DI has an internal weak pull-up. DI captures data on the rising edge of CCLK.

In SPI or SPIm mode the DI/CSSPI0N becomes a low true Chip Select output that drives the SPI Serial Flash chip select.

DOUT/CSON

The DOUT/CSON pin is an output pin and has two purposes.

For serial and parallel configuration modes, when BYPASS mode is selected, this pin becomes DOUT (see Figure 15-9). When the device is fully configured a Bypass instruction in the bitstream is executed and the data on DI, or D[0:7] in the case of a parallel configuration mode, will then be routed to the DOUT pin. This allows data to be passed, serially, to the next device. In a parallel configuration mode D0 will be shifted out first followed by D1, D2, and so on.

For parallel configuration mode there is a Flowthrough option as well. When Flowthrough mode is selected this pin becomes Chip Select Out (CSON). When the device is fully configured, and the Flowthrough instruction in the bitstream is executed, the CSON pin is driven low to enable the next device. The data pins, D[0:7], are wired in parallel to each device in the chain (see Figure 15-10).

In SPI mode, the sysCONFIG daisy chaining mode of configuration is not supported.

The DOUT/CSON drives out a high on power-up and will continue to do so until the execution of the Bypass/Flow Through instruction within the bitstream, or until the I/O Type is changed by the user code.

CSN and CS1N

Both CSN and CS1N are active low input pins with weak pull-ups and are used in parallel mode only. These inputs are OR'ed and used to enable the D[0:7] data pins to receive or output a byte of data. *Note: In the 144-pin TQFP and 208-pin PQFP packages, CSN, CS1N and WRITEN are not bonded out.*

When CSN or CS1N is high, the D[0:7], and BUSY pins are tri-stated. CSN and CS1N are interchangeable when controlling the D[0:7], and BUSY pins. Driving both CSN and CS1N high causes the LatticeECP2/M to exit Bypass or Flowthrough mode and resets the Bypass register. If Bypass or Flowthrough mode will not be used then CSN or CS1N may be tied low, i.e. in this case it is only required that one of these pins be driven. The CSN and CS1N pins must remain low while the configuration bitstream is being sent to the device or the configuration will fail.

If SRAM (configuration memory) needs to be accessed using the parallel pins while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve these pins as CSN and CS1N. CSN and CS1N are not connected in the 100-pin TQFP and 208-pin PQFP devices. Note that SRAM may only be read using JTAG or Slave Parallel mode.

WRITEN

The WRITEN pin is an active low input with a weak pull-up and used for parallel mode only. *Note: In the 144-pin TQFP and 208-pin PQFP packages, CSN, CS1N and WRITEN are not bonded out.*

The WRITEN pin is used to determine the direction of the data pins D[0:7]. The WRITEN pin must be driven low in order to clock a byte of data into the device and driven high to clock data out of the device.

If SRAM (configuration memory) needs to be accessed using the parallel pins while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as WRITEN. WRITEN is not connected in the 100-pin TQFP and 208-pin PQFP devices. Note that SRAM may only be read using JTAG or Slave Parallel mode.

BUSY/SISPI

The BUSY/SISPI pin has two functions.

In parallel configuration mode, the BUSY pin is a tri-stated output. The BUSY pin will be driven low by the device only when it is ready to receive a byte of data on D[0:7] or a byte of data is ready for reading. The BUSY pin allows the LatticeECP2/M to pause transfers on the parallel port.

If SRAM (configuration memory) needs to be accessed using the parallel pins while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as BUSY. Note that SRAM may only be read using JTAG or Slave Parallel mode.

In SPI or SPI mode configuration modes, the BUSY/SISPI pin becomes an output that drives control and data to the SPI Serial Flash. Control and data are output on the falling edge of CCLK. If SPI memory needs to be accessed

using the SPI port while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as SISPI.

D[0]/SPIFASTN

The D[0]/SPIFASTN pin has two functions.

In parallel mode this pin is D[0] and operates in the same way as D[1:6] below. Taken together D[0:7] form the parallel data bus, D[0] is the most significant bit in the byte. As with D[1:6], if SRAM (configuration memory) needs to be accessed using the parallel pins while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as D[0]. Note that SRAM may only be read using JTAG or Slave Parallel mode.

In SPI or SPIm mode the D[0]/SPIFASTN pin becomes an input. SPIFASTN is sampled on the rising edge of INITN. If SPIFASTN is high the LatticeECP2/M will use SPI Serial Flash read op-code 03 (hex). Read op-code 03 (hex) is the standard read command used by all “25” series SPI Serial Flash. If SPIFASTN is low the LatticeECP2/M will use SPI Serial Flash fast read op-code 0B (hex). The fast read op-code 0B (hex) accommodates higher frequency read clocks, exact clock speeds can be found in the SPI Serial Flash manufacturer’s data sheet.

If SPI memory needs to be accessed using the SPI port while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as SPIFASTN.

When using the SPI or SPIM mode the SPIFASTN pin should either be tied high or low. It must not be left floating or configuration problems will occur.

Not all SPI Serial Flash support the 0B (hex) fast read op-code, consult the manufacturer’s data sheet. Care must also be taken not to exceed the signal integrity capabilities of the PCB layout.

D[1:6]

The D[1:6] pins support parallel mode only. The D[1:6] pins are tri-statable bi-directional I/O pins used for data write and read. When the WRITEN signal is low, and the CSN and CS1N pins are low, the D[1:6] pins become data inputs. When the WRITEN signal is driven high, and the CSN and CS1N pins are low, the D[1:6] pins become data outputs. If either CSN or CS1N is high D[1:6] will be tri-state.

If SRAM (configuration memory) needs to be accessed using the parallel pins while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as D[1:6]. Note that SRAM may only be read using JTAG or Slave Parallel mode.

Care must be exercised during read back of EBR or PFU memory. It is up to the user to ensure that reading these RAMs will not cause data corruption; corruption may be caused when these RAMs are read while being accessed by user code.

D[7]/SPID0

The D[7]/SPID0 pin has two functions.

In parallel mode this pin is D[7] and operates in the same way as D[1:6] above. Taken together D[0:7] form the parallel data bus, D[7] is the least significant bit in the byte. As with D[1:6], if SRAM (configuration memory) needs to be accessed using the parallel pins while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as D[7]. Note that SRAM may only be read using JTAG or Slave Parallel mode.

In SPI or SPIm mode the D[7]/SPID0 pin becomes an input and should be wired to the output data pin of the SPI Serial Flash. The data on SPID0 is clocked in on the rising edge of CCLK. If SPI memory needs to be accessed using the SPI port while the part is in user mode (the DONE pin is high) then the PERSISTENT preference must be set to ON to preserve this pin as SPID0.

ispJTAG Pins

The ispJTAG pins are standard IEEE 1149.1 TAP (Test Access Port) pins. The ispJTAG pins are dedicated pins and are always accessible when the LatticeECP2/M device is powered up. While the device is under 1149.1 or 1532

JTAG control the dedicated programming pins INITN, DONE, and CCLK have no meaning. This is because a boundary scan cell will control each pin, per the IEEE standard, rather than normal internal logic. While the LatticeECP2/M is under JTAG control the PROGRAMN pin will be ignored.

These pins are powered by V_{CCJ} .

TDO

The Test Data Output pin is used to shift out serial test instructions and data. When TDO is not being driven by the internal circuitry, the pin will be in a high impedance state. This pin should be wired to TDO of the JTAG connector, or to TDI of a downstream device in a JTAG chain. An internal pull-up resistor on the TDO pin is provided. The internal resistor is pulled up to V_{CCJ} .

TDI

The Test Data Input pin is used to shift in serial test instructions and data. This pin should be wired to TDI of the JTAG connector, or to TDO of an upstream device in a JTAG chain. An internal pull-up resistor on the TDI pin is provided. The internal resistor is pulled up to V_{CCJ} .

TMS

The Test Mode Select pin controls test operations on the TAP controller. On the falling edge of TCK, depending on the state of TMS, a transition will be made in the TAP controller state machine. An internal pull-up resistor on the TMS pin is provided. The internal resistor is pulled up to V_{CCJ} .

TCK

The test clock pin, TCK, provides the clock to run the TAP controller state machine, which loads and unloads the JTAG data and instruction registers. TCK can be stopped in either the high or low state and can be clocked at frequencies up to that indicated in the device data sheet. The TCK pin supports hysteresis; the typical hysteresis is approximately 100mV when $V_{CCJ} = 3.3V$. The TCK pin does not have a pull-up. A pull-down resistor between TCK and ground on the PCB of 4.7 K is recommended to avoid inadvertent clocking of the TAP controller as V_{CC} ramps up.

When downloading an encrypted bitstream file to the LatticeECP2/M S-Series devices, the user must adhere to the appropriate conditions for the TCK signal. These conditions are shown in TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#).

Optional TRST

Test Reset, TRST, is not supported on the LatticeECP2/M.

V_{CCJ}

Having a separate JTAG V_{CC} (V_{CCJ}) pin lets the user apply a voltage level to the JTAG port that is independent from the rest of the device. Valid voltage levels are 3.3V, 2.5V, 1.8V, 1.5V, and 1.2V, but the voltage used must match the other voltages in the JTAG chain. V_{CCJ} must be connected even if JTAG is not used.

Please see [In-System Programming Design Guidelines for ispJTAG Devices](#) for further information.

Configuration and JTAG Pin Physical Description

All of the sysCONFIG dedicated and dual-purpose pins are part of Bank 8. Bank 8 V_{CCIO} determines the output voltage level of these pins, input thresholds are determined by the I/O Type selected in the ispLEVER Design Planner (default is 3.3V LVCMOS) or Diamond Spreadsheet View.

JTAG voltage levels and thresholds are determined by the V_{CCJ} pin, allowing the LatticeECP2/M to accommodate JTAG chain voltages from 1.2V to 3.3V.

Configuration Modes

The LatticeECP2/M devices support many different configuration modes, utilizing either serial or parallel data paths. On power-up, when a JTAG Refresh instruction is issued, or when the PROGRAMN pin is toggled, the CFG[2:0] pins are sampled to determine the configuration mode. See Table 15-3 above for a list of available configuration modes.

The following sub-sections break down each configuration mode. For more information on the options for each mode, see the section below entitled Configuration Options.

SPI Mode

The LatticeECP2/M offers a direct connection to memories that support the SPI Serial Flash standard (see Table 15-6). By setting the configuration pins, CFG[2:0], to all zeros the LatticeECP2/M will configure from the SPI interface. The SPI interface supports two configuration topologies:

- One FPGA configured from one SPI Serial Flash
- Multiple FPGAs configured from one SPI Serial Flash

The required boot memory size for each of the ECP2/M device sizes is shown in Table 15-4. The values shown are for a single LatticeECP2/M device. The size for a dual-boot application would be twice that shown.

Table 15-4. Maximum Configuration Bits - SPI Flash Mode Bitstream File

| Device | Bitstream Size (Mb) | SPI Flash (Mb) | Dual Boot SPI Flash (Mb) |
|-----------|---------------------|----------------|--------------------------|
| ECP2-6 | 1.5 | 2 | 4 / 8 ² |
| ECP2-12 | 2.9 | 4 | 8 |
| ECP2-20 | 4.5 | 8 | 16 |
| ECP2-35 | 6.3 | 8 | 16 |
| ECP2-50 | 8.9 | 16 | 32 |
| ECP2-70 | 13.3 | 16 | 32 |
| ECP2M-20 | 5.9 | 8 | 16 |
| ECP2M-35 | 9.8 | 16 | 32 |
| ECP2M-50 | 15.8 | 16 | 64 |
| ECP2M-70 | 19.8 | 32 | 64 |
| ECP2M-100 | 25.6 | 32 | 64 |

1. These values apply for both encrypted and unencrypted bitstream files in the SPI Flash mode except as noted below.
2. For the LatticeECP2-6 S-Series device, the dual Boot Flash size required is 8 Mb due to the number of sectors required.

Table 15-5. Maximum Configuration Bits - Serial and Parallel Mode Bitstream File

| Device | All Modes | Slave Serial Mode | Slave Parallel Mode |
|-----------|---------------------------------|-------------------------------|-------------------------------|
| | Unencrypted Bitstream Size (Mb) | Encrypted Bitstream Size (Mb) | Encrypted Bitstream Size (Mb) |
| ECP2-6 | 1.5 | 2.3 | 7.5 |
| ECP2-12 | 2.9 | 4.3 | 14.2 |
| ECP2-20 | 4.5 | 6.7 | 22.0 |
| ECP2-35 | 6.3 | 9.4 | 31.2 |
| ECP2-50 | 8.9 | 13.4 | 44.3 |
| ECP2-70 | 13.3 | 20.0 | 66.1 |
| ECP2M-20 | 5.9 | 8.9 | 29.5 |
| ECP2M-35 | 9.8 | 14.8 | 48.9 |
| ECP2M-50 | 15.8 | 23.7 | 78.6 |
| ECP2M-70 | 19.8 | 29.7 | 98.6 |
| ECP2M-100 | 25.6 | 38.5 | 127.6 |

The estimated time for configuration can be calculated by dividing the bitstream size (in bits) from Table 15-4 by the CCLK frequency. The CCLK frequency can be set using the global preferences tab within the ispLEVER Design Planner or the Spreadsheet View (Global Preferences tab) in Diamond. For more information on setting the CCLK frequency, please see the Master Clock section and the D[0]/SPIFASTN pin section of this document.

When downloading an encrypted bitstream file to the LatticeECP2/M S-Series devices, the user must adhere to the appropriate conditions for the CCLK signal. These conditions are shown in TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#).

Table 15-6. SPI Serial Flash Vendor List

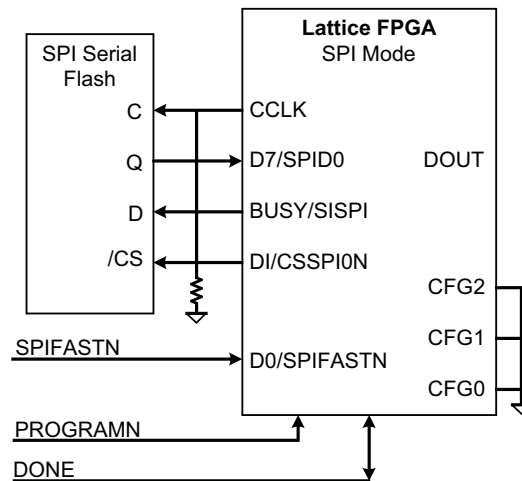
| Vendor | Part Number |
|----------------------------|-------------------------|
| ST Microelectronics | M25Pxx |
| Winbond | W25Pxx |
| Silicon Storage Technology | SST25VFxx, SST25LFxx |
| Spansion | S25FLxx |
| Atmel | AT25Fxx |
| NexFlash | NX25Pxx |
| Macronix | MX25Lxx |

Note: This is not meant to be an exhaustive list and may be updated from time to time.

One FPGA, One SPI Flash

The simplest SPI configuration consists of one SPI Serial Flash connected to one LatticeECP2/M, as shown in Figure 15-1. This is also the recommended method for use when downloading an encrypted bitstream file to the LatticeECP2/M S-Series devices.

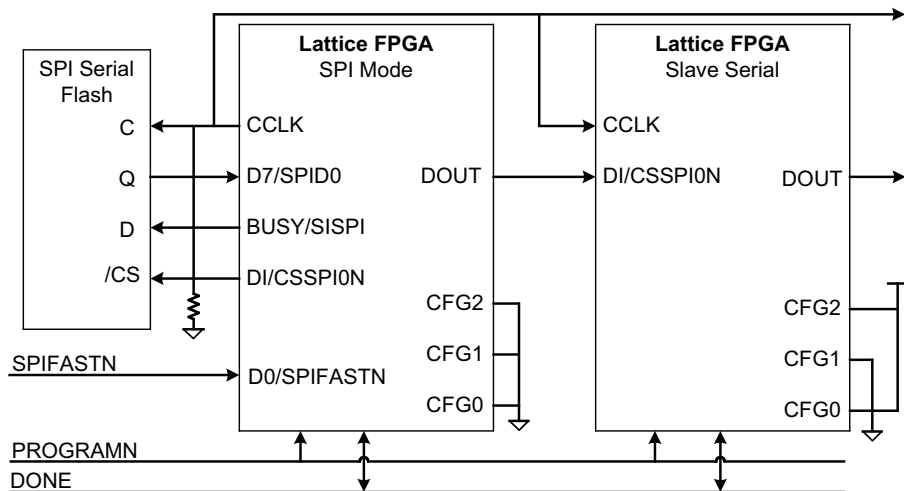
Figure 15-1. One FPGA, One SPI Serial Flash



Multiple FPGA, One SPI Flash

With a sufficiently large SPI Flash multiple FPGAs can be configured as shown in Figure 15-2. The first FPGA is configured in SPI mode; the following FPGAs are configured in Slave Serial mode.

Figure 15-2. Multiple FPGAs, One SPI Serial Flash



Note: This method is not available when using encrypted bitstream files with the LatticeECP2/M S-Series devices. Please refer to the *LatticeECP2/M S-Series Configuration Encryption Usage Guide*, TN1109, for more information about using encrypted bitstream files.

SPIm Mode

Externally, except for the CFG pins, SPIm mode looks like SPI mode, they use the same SPI Serial Flash devices, and are wired to the FPGA in the same way (see Figure 15-6). The SPIm mode does not support multiple FPGAs being configured from one SPI serial Flash as shown in Figure 15-2. Internally the two modes are treated differently.

SPI mode treats the SPI Serial Flash as a single block of storage starting at address zero. The SPIm mode treats the SPI flash memory as discrete blocks of memory rather than a single block of memory. This allows the storage of separate configuration images in separate blocks of memory. SPIm supports dual configuration (or boot) images, here referred to as a “golden” image and a primary image.

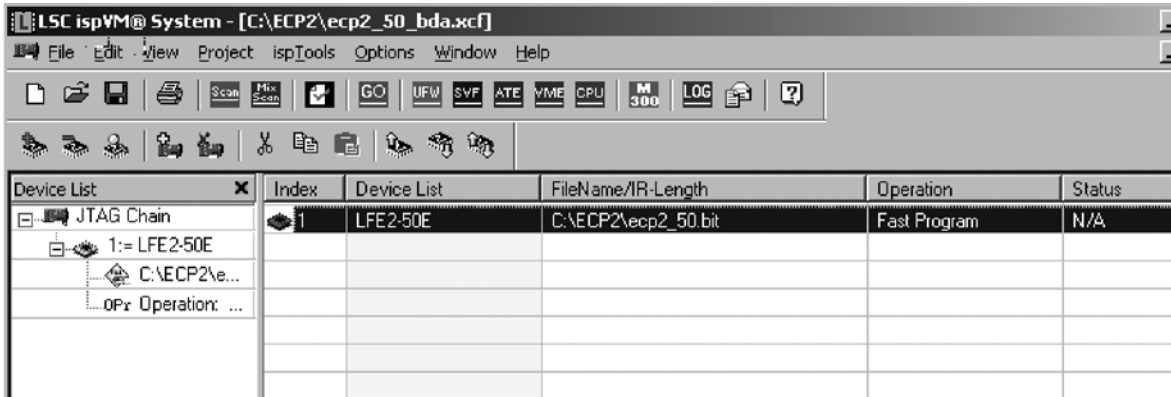
A golden image is used when there is the possibility that corrupt data could be inadvertently loaded into the SPI Serial Flash, such as during remote updates. For instance, if the Flash erase or program procedure is interrupted, perhaps due to a power failure, then the Flash will contain corrupt data and the system could be rendered inoperable. Ideally the FPGA should detect that the data is corrupt and boot from a known good, or golden, boot image. This is exactly what SPIm does.

The golden image is stored at the beginning of the Flash address space; the updatable, or primary, image is above the golden image. During configuration, if the FPGA detects data corruption in the primary image, it will automatically reboot from the golden image. Each time the FPGA powers up, the PROGRAMN pin is toggled, or a JTAG Refresh instruction is issued, it will try to configure from the primary image first. Note that if the LatticeECP2/M detects that the data in the golden image is corrupt as well INITN will be driven low and the part will stop trying to configure.

Dual Boot Image Setup

In order to use dual configuration files the files must first be properly stored within the SPI Serial Flash. Lattice ispVM™ System software makes this easy.

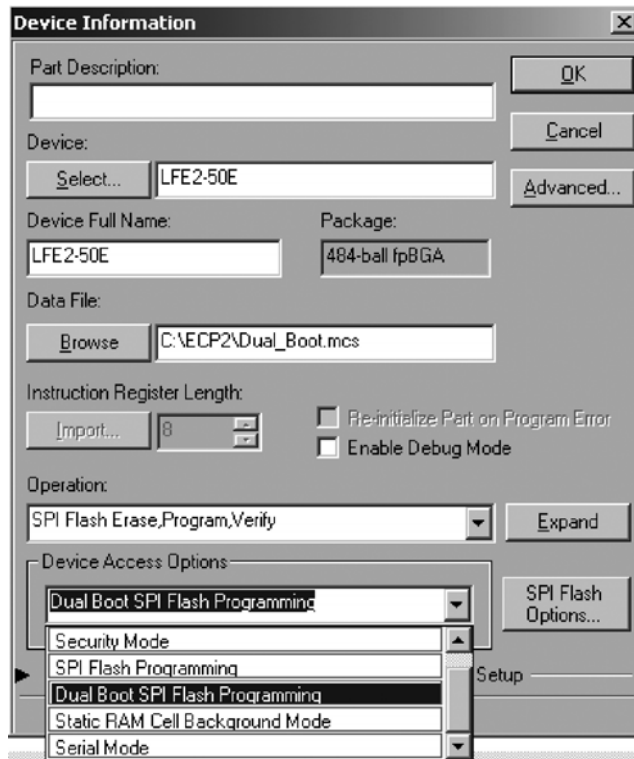
Figure 15-3. ispVM Main Window



First, create the desired files using ispLEVER or Diamond. Depending on the application, these files might be the same design or different designs. There is nothing special about these files, in other words they contain all of the information needed to fully configure the FPGA.

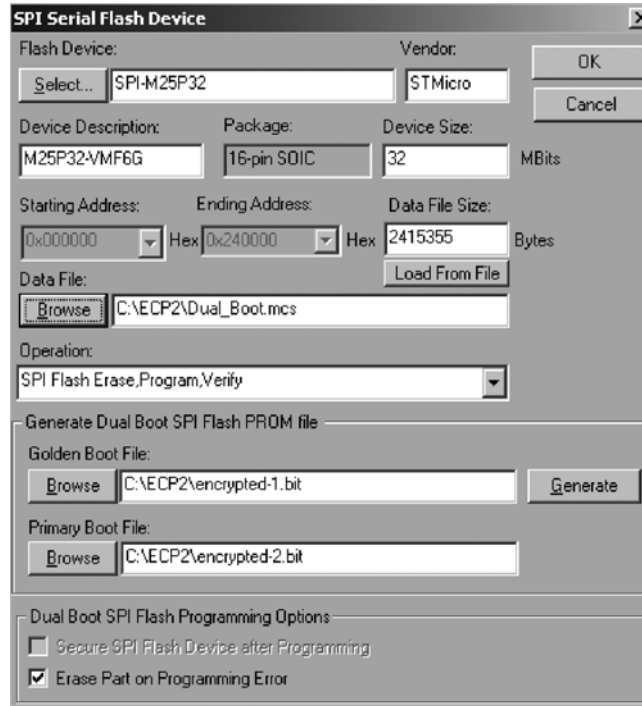
Next, open ispVM (see Figure 15-3), do a scan of the board by clicking on the **SCAN** button on the toolbar, and then double click on the row in the chain that has the LatticeECP2/M. You will now see the Device Information window (see Figure 15-4).

Figure 15-4. Device Information Window



From the Device Options drop-down box select **Dual Boot SPI Flash Programming**. Then click on the **SPI Flash Options** button to open the SPI Serial Flash Device window (see Figure 15-5). In this window click on **Select** and choose the SPI Flash that’s mounted on the board.

Figure 15-5. SPI Serial Flash Device Window



Second, click on **Browse** to select an output file name.

Third, select the operation, such as **SPI Flash Erase, Program, Verify**.

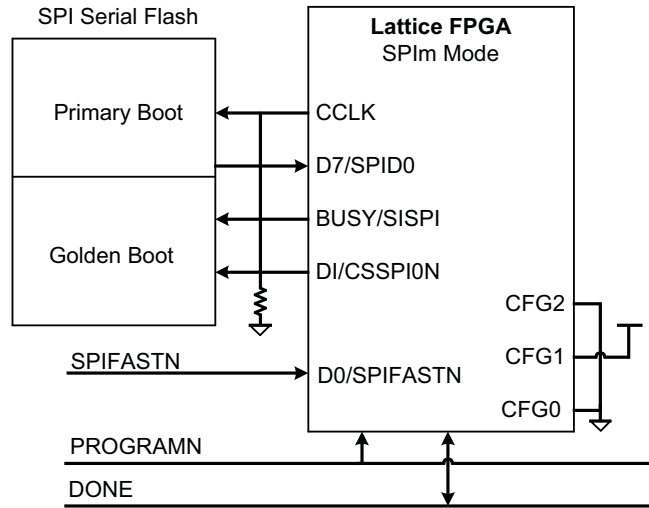
Fourth, select the golden file and primary file. Note that these may be encrypted for the LatticeECP2/M "S" version or non-encrypted files. If they are encrypted files they must both be encrypted with the same key.

And finally, click on the **Generate** button. When file generation is complete, click on **OK** to get back to the main ispVM window. To program the file into the SPI Serial Flash just click on the **GO** button on the toolbar.

At power-up, when the PROGRAMN pin is toggled, or when a JTAG Refresh instruction is issued, the LatticeECP2/M reads the primary file from SPI Serial Flash. If a CRC error is found then the LatticeECP2/M will re-boot automatically, reading configuration data from the golden file instead of the primary file. Note that if an error is found in the golden file the LatticeECP2/M will drive the INITN pin low and stop trying to configure.

Note that the flow specified here is for initial programming of the SPI Serial Flash. During a field update of the SPI Serial Flash it is expected that only the primary configuration file will be updated, not the golden file. This is important because it guarantees the availability of a known good configuration file.

Figure 15-6. SPIm, Dual Configuration Images



Note: The CSSPI1N pin should not be connected.

Programming SPI Serial Flash

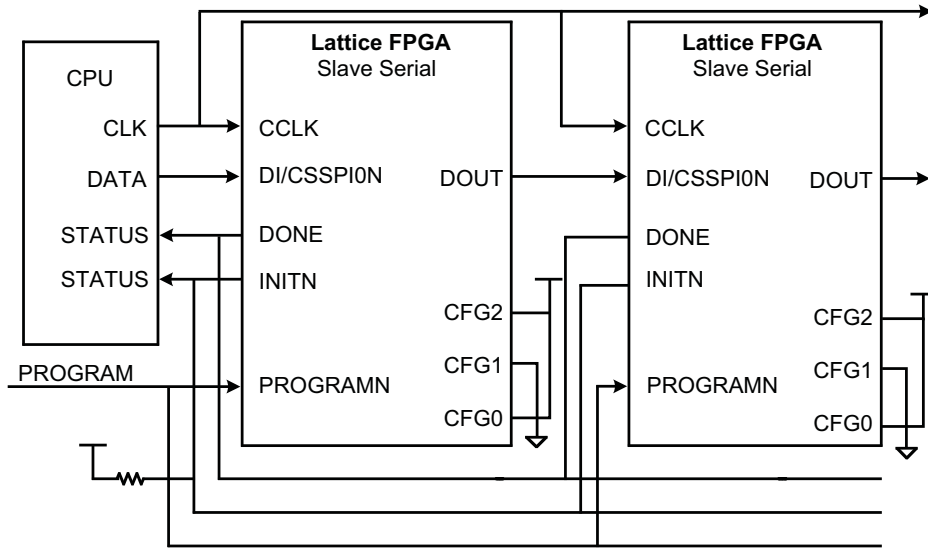
The LatticeECP2/M contains dedicated hardware that allows JTAG to access the SPI port, allowing ispVM, embedded hardware, or ATE equipment to program the Flash while it is on the board. In order to program SPI Serial Flash using JTAG, the CFG pins must be set to SPI or SPIm (see Table 15-3). Please refer to the ispVM Help system for more information.

Slave Serial Mode

In Slave Serial mode the CCLK pin becomes an input, receiving the clock from an external device. The LatticeECP2/M accepts data on the DI pin on the rising edge of CCLK. Slave Serial only supports writes to the FPGA, it does not support reading from the FPGA.

After the device is fully configured, if the Bypass option has been set, any additional data clocked into DI will be presented to the next device via the DOUT pin, as shown in Figure 15-7.

Figure 15-7. Serial Mode Daisy Chain



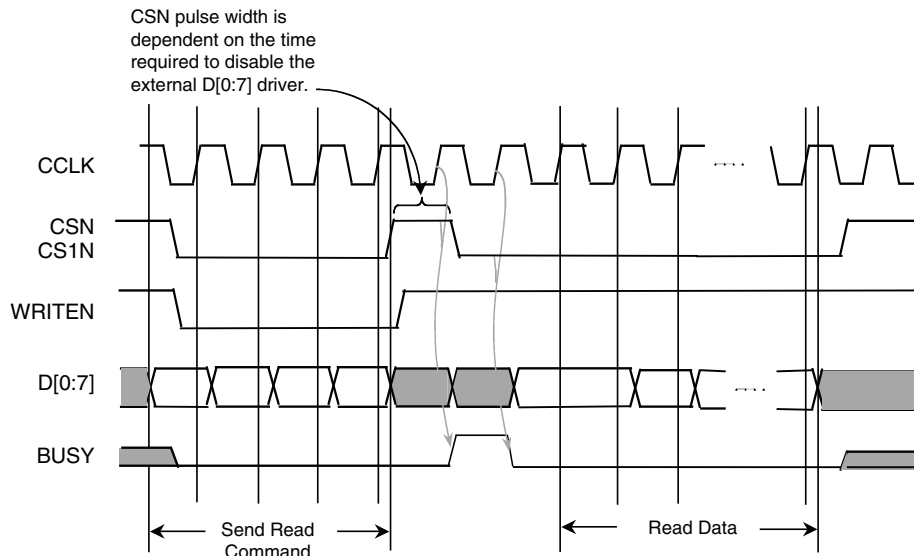
Note: In the Slave Serial Mode, the Bypass option is not supported when using encrypted bitstream files with the LatticeECP2/M S-Series devices. Please refer to the *LatticeECP2/M S-Series Configuration Encryption Usage Guide*, TN1109, for more information about using encrypted bitstream files.

Slave Parallel Mode

In Slave Parallel mode a host system sends the configuration data in a byte-wide stream to the LatticeECP2/M. The CCLK, CSN, CS1N, and WRITEN pins are driven by the host system. WRITEN, CSN, and CS1N must be held low to write to the device; data is input from D[0:7]. D0 is the MSb and D7 is the LSb.

Slave Parallel mode can also be used for readback of the internal configuration. By driving the WRITEN pin low, and CSN and CS1N low, the device will input the readback instructions on the D[0:7] pins; WRITEN is then driven high and read data is output on D[0:7] (see Figure 15-8). In order to support readback, the PERSISTENT bit must be set to ON in ispLEVER Design Planner or in the Diamond Spreadsheet View (Global Preferences tab). *Note: SLAVE PARALLEL Mode is not available in the 100-pin TQFP and 208-pin PQFP package offerings since the CSN, CS1N and WRITEN pins are not bonded out for these packages.*

Figure 15-8. Parallel Port Read Timing Diagram



The host sends the preamble, BDB3 (hex), and then sends the read command. The LatticeECP2/M sends read data on D[0:7], driving BUSY high as needed to pause data flow. For an example bitstream see Table 15-7. Table 15-8 lists the various read commands. Note that the sample bitstream and the list of read commands are for reference only; to help the user better understand the flow. The actual bitstream, containing the read commands, is generated by ispLEVER or Diamond and ispVM, the host, toggles the control signals and sends the bitstream.

Table 15-7. Parallel Port Read Bitstream Example

| Frame | Contents | Description |
|----------------|----------------------|-----------------------------|
| Header | 1111...1111 | 2 Dummy Bytes |
| | 10111101 10110011 | 2-byte Preamble (BDB3) |
| Verify ID | | 8 bytes of command and data |
| Reset Address | | 4 bytes of command and data |
| Read Increment | | 4 bytes of command and data |

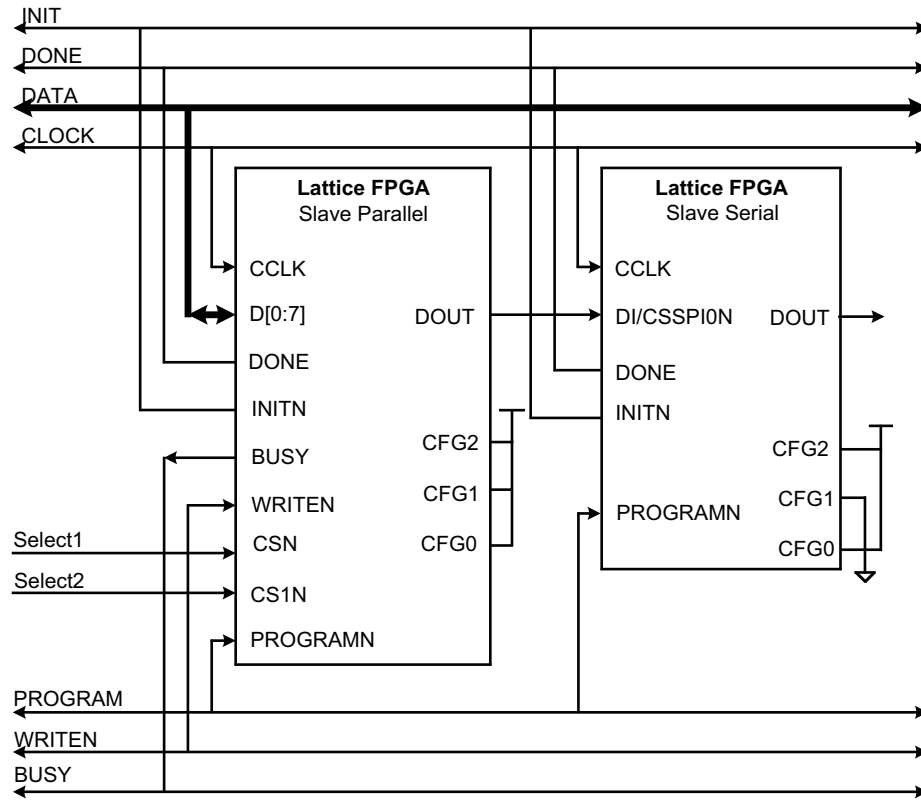
Table 15-8. Parallel Port Read Commands

| Command | 32-bit Opcode | Function |
|-----------------|---------------|---|
| Reset Address | E2000000 | Reset address register to point to the first data frame |
| Read Increment | 01vvvvvv | Read back the configuration memory frame selected by the address register and post increment the address |
| Read Usercode | 83000000 | Read the content of the USERCODE register |
| Read Ctrl Reg 0 | 84000000 | Read the content of Control Register 0 |
| Read CRC | 86000000 | Read CRC register content |
| Read ID Code | 87000000 | Read ID code |
| NO OP | FF | No operation. This is an 8-bit Opcode. Extra bits should not be appended to this Opcode as this could cause INITN to go low during configuration. |

Note: x = don't care, v = variable.

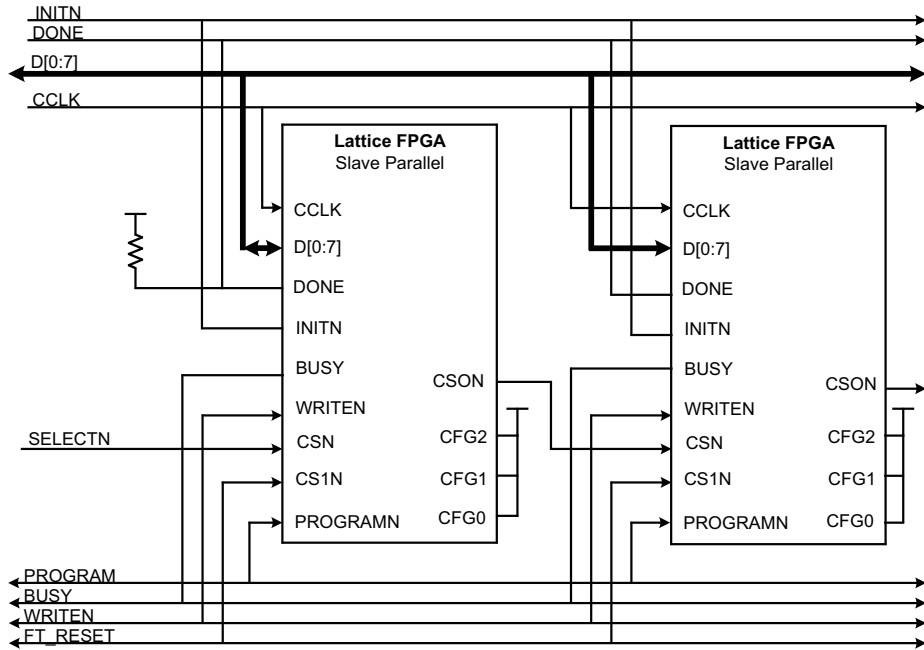
Slave Parallel mode can support two types of overflow, Bypass and Flowthrough. After the first device has received all of its configuration data, and the Bypass command is detected in the bitstream, the data presented to the D[0:7] pins will be serialized and bypassed to the DOUT pin (see Figure 15-9). If the Flowthrough command is detected in the bitstream, instead of the bypass command, the CSON signal will drive the following parallel mode device's chip select low as shown in Figure 15-10. If either type of overflow is active, driving both the CSN and CS1N pins high will reset overflow, i.e. take the device out of overflow.

Figure 15-9. Slave Parallel with Bypass Option



Note: In Slave Parallel mode, the Bypass option is not supported when using encrypted bitstream files with the LatticeECP2/M S-Series devices. Please refer to the *LatticeECP2/M S-Series Configuration Encryption Usage Guide*, TN1109, for more information about using encrypted bitstream files.

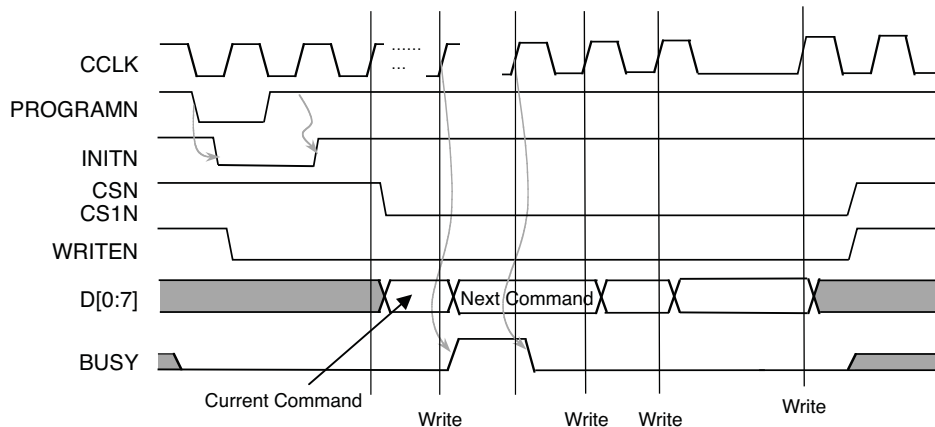
Figure 15-10. Slave Parallel with Flowthrough



Note: In Slave Parallel mode, the Flowthrough option is not supported when using encrypted bitstream files with the LatticeECP2/M S-Series devices. Please refer to the *LatticeECP2/M S-Series Configuration Encryption Usage Guide*, TN1109, for more information about using encrypted bitstream files.

To support asynchronous configuration, where the host may provide data faster than the FPGA can accept it, Slave Parallel mode can use the BUSY signal. By driving the BUSY signal high the Slave Parallel device tells the host to pause sending data. Please note that all data and control are still synchronous with CCLK, asynchronous refers to the ability to throttle the data transfer using BUSY. See Figure 15-11.

Figure 15-11. Parallel Port Write Timing Diagram



Note: When downloading an encrypted bitstream file to the LatticeECP2/M S-Series devices, the user must adhere to the appropriate conditions for the CCLK signal. These conditions are shown in the *LatticeECP2/M S-Series Configuration Encryption Usage Guide*, TN1109.

The CSN and CS1N pins must remain low while the configuration bitstream is being sent to the device or the configuration will fail. To temporarily stop the write process, the user can pause the CCLK signal and the data. An example of this is shown in Figure 15-11.

ispJTAG Mode

The LatticeECP2/M device can be configured through the ispJTAG port using either Fast Program or IEEE 1532 mode. The JTAG port is always on and available, regardless of the configuration mode selected. The IEEE 1532 mode is called Erase, Program, Verify in ispVM System.

Fast Program

Fast Program can be thought of as serial configuration using the JTAG port. The data file used for Fast Program is the same as a file used for a sysCONFIG Serial mode configuration, in other words there is a header, a preamble, and configuration data. Fast Program will result in a faster configuration time since the bitstream contains CRC checking so a time consuming post programming bit by bit verification is not required. The SVF and VME file formats also support Fast programming.

During JTAG configuration the Boundary Scan cells take control of the LatticeECP2/M I/Os. The Boundary Scan cells will usually drive the I/Os to a tri-state level but this can be controlled and even customized using ispVM. Note that PROGRAMN, INITN, and DONE have no meaning since they are controlled by the Boundary Scan cells during JTAG configuration. However, the INITN and DONE do indicate configuration status after JTAG configuration is completed.

IEEE 1532

Besides Fast Program the LatticeECP2/M can also be configured through JTAG using the IEEE 1532 Standard. The IEEE 1532 mode is called Erase, Program, Verify in ispVM System. IEEE 1532 configuration files contain JTAG instructions, as well as the configuration data. IEEE 1532 files, including ISC, SVF, and VME, can be created using ispVM's Universal File Writer (UFW). These files can be used by ispVM or by third party ATE equipment. These files can also be used in embedded situations, where an on-board processor provides the data while controlling the JTAG signals (this is called ispVM Embedded, more information can be found in ispVM's help facility). IEEE 1532 programming will be slower than the Fast Program mode since it requires a post programming bit by bit verification.

During JTAG configuration the Boundary Scan cells take control of the LatticeECP2/M I/Os. The Boundary Scan cells will usually drive the I/Os to a tri-state level but this can be controlled and even customized using ispVM.

Note that PROGRAMN, INITN, and DONE have no meaning since they are controlled by the Boundary Scan cells during JTAG configuration. However, the DONE pin will indicate configuration status after IEEE 1532 configuration is completed.

Transparent Read Back

The ispJTAG transparent read back mode allows the user to read the content of the device while the device remains fully functional. All I/O, as well as the non-JTAG configuration pins, remain under internal logic control during a Transparent Read Back. The device enters the Transparent Read Back mode through a JTAG instruction. The user must ensure that Transparent Read Back does not access EBR or distributed RAM at the same time internal logic is accessing these resources or corruption of the RAM may occur.

Boundary Scan and BSDL Files

The LatticeECP2/M BSDL files can be found on the Lattice Semiconductor web site. The boundary scan ring covers all of the I/O pins, as well as the dedicated and dual-purpose sysCONFIG pins. Note that PROGRAMN, CCLK, and the CFG pins are observe only (BC4, JTAG read-only) boundary scan cells.

Configuration Options

Several configuration options are available for each configuration mode.

- When daisy chaining multiple FPGA devices an overflow option is provided for serial and parallel configuration modes
- When using SPI or SPIm mode, the master clock frequency can be set
- A security bit can be set to prevent SRAM readback

- The bitstream can be compressed
- The Persistent option can be set
- Configuration pins can be protected
- DONE pin options can be selected

By setting the proper parameter in the Lattice design software the selected configuration options are set in the generated bitstream. As the bitstream is loaded into the device the selected configuration options take effect. These options are described in the following sections.

Bypass Option

In ispLEVER, the Bypass option can be set by using the Bitgen properties. Or, a chain of bitstreams can be assembled and Bypass set using ispVM. To set the Bypass option in Diamond, see Appendix A. The Bypass option can be used in parallel and serial mode daisy chains. The Bypass option is not supported when using SPIm configuration. The Bypass option is not supported when using encrypted bitstream files with the LatticeECP2/M S-Series devices. Please refer to TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#), for more information about using encrypted bitstream files.

When the first device completes configuration, and a Bypass command is input from the bitstream, any additional data coming into the FPGA configuration port will overflow serially on DOUT. This data is applied to the DI pin of the next device (downstream devices must be set to slave serial mode).

In serial configuration mode the Bypass option connects DI to DOUT via a bypass register. The bypass register is initialized with a '1' at the beginning of configuration and will stay at that value until the Bypass command is executed. In parallel configuration mode the Bypass option causes the excess data coming in on D[0:7] to be serially shifted to DOUT. The serialized data is shifted to DOUT through a bypass register. D0 will be shifted out first followed by D1, D2, and so on. Once the Bypass option starts the device will remain in Bypass until the Wake-up sequence completes. In parallel mode, if Bypass needs to be aborted, drive both CSN and CS1N high, this acts as a Bypass reset signal.

Flowthrough Option

As with Bypass, Flowthrough can be set in the Bitgen properties in ispLEVER and in the Strategy Process Options settings. To set the Flowthrough option in Diamond, see Appendix A. The Flowthrough option can be used with parallel daisy chains only. The Flowthrough option is not supported when using SPIm configuration. The Flowthrough option not supported when using encrypted bitstream files with the LatticeECP2/M S-Series devices. Please refer to TN1109, [LatticeECP2/M Configuration Encryption Usage Guide](#), for more information about using encrypted bitstream files.

When the first device completes configuration, and a Flowthrough command is input from the bitstream, the CSON pin is driven low. In addition to driving CSON low, Flowthrough also tri-states the device's D[0:7] and BUSY pins in order to avoid contention with the other daisy-chained devices. Once the Flowthrough option starts the device will remain in Flowthrough until the Wake-up sequence completes. If Flowthrough needs to be aborted drive both CSN and CS1N high, this acts as a Flowthrough reset signal.

Master Clock

If the CFG pins indicate an SPI or SPIm mode the CCLK pin will become an output, with the frequency set by the user. The default Master Clock Frequency is 3.1 MHz. For a complete list of the supported Master Clock frequencies, please see the [LatticeECP2/M Family Data Sheet](#). When using the LatticeECP2/M S-Series devices, the available frequencies are restricted, as shown in the data sheet.

The user can change the Master Clock frequency by setting the MCCLK_FREQ global preference in the Lattice ispLEVER Design Planner. To set this option in Diamond, see Appendix A. One of the first things loaded during configuration is the MCCLK_FREQ parameter; once this parameter is loaded the frequency changes to the selected value using a glitchless switch. Care should be exercised not to exceed the frequency specification of the slave devices or the signal integrity capabilities of the PCB layout.

Configuration time is computed by dividing the maximum number of configuration bits, as given in Table 15-4 above, by the Master Clock frequency.

Security Bit

Setting the CONFIG_SECURE option to ON prevents readback of the SRAM from JTAG or the sysCONFIG pins. When CONFIG_SECURE is set to ON the only operations available are erase and write. The security fuse is updated as the last operation of SRAM configuration. If a secured device is read it will output all zeros.

For LatticeECP2/M devices the CONFIG_SECURE option is accessed via the Design Planner in ispLEVER. To set this option in Diamond, see Appendix A. The default is OFF.

For the LatticeECP2/M S-Series devices (part numbers ECP2-XXES and ECP2MXXES) the CONFIG_SECURE option is accessed using the **Security Setting** option under the **Tools** menu.

Compress Bitstream

Setting the global COMPRESS_CONFIG option to ON in ispLEVER Design Planner will cause the software to generate a compressed bitstream. To set this option in Diamond, see Appendix A. The LatticeECP2/M will automatically decompress the bitstream as it comes into the device. The actual amount of compression varies according to the data pattern in the uncompressed bitstream. Though unlikely, it is theoretically possible for the compressed bitstream to be larger than the uncompressed bitstream.

Compressing the bitstream can result in faster configuration. The default setting is OFF.

Persistent Option

The PERSISTENT Option is set using ispLEVER Design Planner (default is OFF). To set this option in Diamond, see Appendix A. PERSISTENT serves two purposes.

Setting PERSISTENT ON tells the place and route tools that it may not use any of the sysCONFIG pins associated with the parallel port (all of the dual-purpose pins except DI) or the SPI Port pins.

Setting PERSISTENT ON also sets a hardware fuse. So, not only are the pins reserved in software, they are also reserved in hardware.

PERSISTENT is set to ON when the user wants to be able to read the SRAM configuration memory using the Slave Parallel port. In order to perform a read using the parallel port the user must first send a read command, setting PERSISTENT ON allows the parallel port to listen for this command while in user mode (the DONE pin is high). If the design does not require this function, the PERSISTENT option should be set to OFF.

The PERSISTENT preference must also be set to ON if the SPI memory needs to be accessed using the SPI port while the part is in user mode (the DONE pin is high) to preserve the SPI port pins.

Configuration Mode

Just as the CFG pins tell the hardware which port to configure from; the CONFIG_MODE option tells the software which port will be used. CONFIG_MODE allows the user to protect dual-purpose sysCONFIG pins. For example setting CONFIG_MODE to SPI will keep the Place and Route tools from using the SPI pins as general purpose I/O. The user, however, is still free to assign these pins as GPIO, but a warning will be generated as a reminder that there are certain precautions (see the section above entitled Configuration Pins).

Available options are NONE, JTAG, SPI, SPIm, Slave Serial, and Slave Parallel. The default is Slave Serial.

DONE_OD, DONE_EX

During configuration the DONE pin is low. Once configuration is complete, indicated by the setting of the internal Done bit, the device wake-up sequence takes place and then the DONE pin goes high. Under most circumstances, this flow is exactly what is needed, however, if there are several devices in one configuration chain, delay of the wake-up sequence may be desirable in order to “synchronize” the wake-up of all devices in the chain. There are two options that allow for this synchronization. These options are set in ispLEVER Design Planner. To set these options in Diamond, see Appendix A.

DONE_OD defaults to ON. DONE_OD ON forces the DONE pin type to be open-drain. When connecting multiple DONE pins together all of the pins should be open-drain, however it may be advantageous to have an actively driven DONE pin on the last device. Setting DONE_OD to OFF makes the DONE pin an actively driven pin, rather than open-drain.

DONE_EX defaults to OFF. Setting DONE_EX to ON will cause LatticeECP2/M to sample the DONE pin and, if the DONE pin is held low externally, delay the wake-up sequence. Setting DONE_EX to OFF will cause the device to wake-up as soon as the internal Done bit is set.

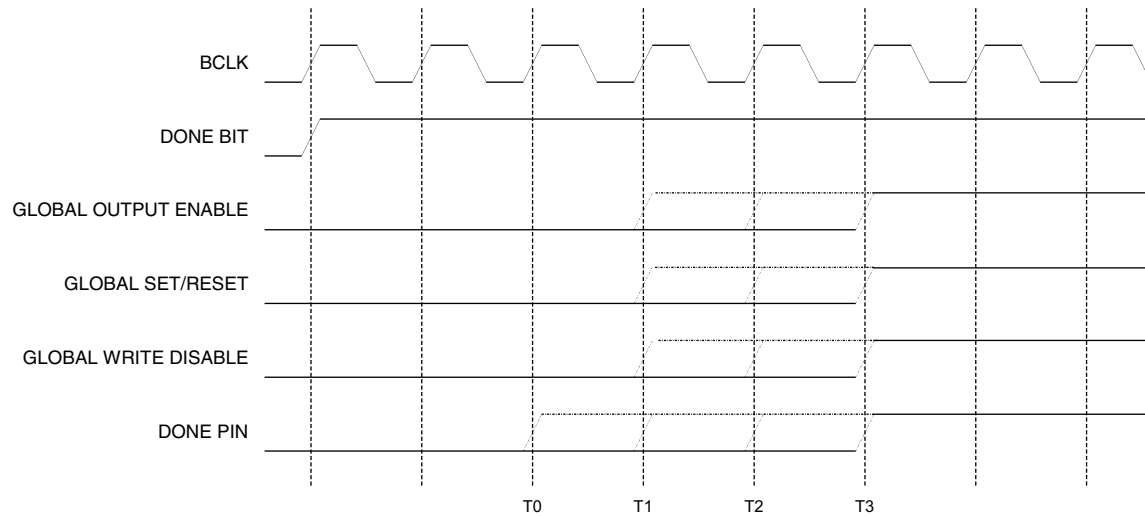
Device Wake-Up

When configuration is complete the device will wake up in a predictable fashion. Wake-Up occurs after successful configuration, without errors, and provides the transition from Configuration Mode to User Mode. The Wake-Up process begins when the internal Done bit is set.

Table 15-9 provides a list of the Wake-Up sequences supported by the LatticeECP2/M; Figure 15-12 shows the Wake-Up timing. The WAKE_UP defaults work fine for the vast majority of applications. To set the WAKE_UP options in Diamond, see Appendix A.

Table 15-9. Wake-Up Options

| Sequence | Phase T0 | Phase T1 | Phase T2 | Phase T3 |
|--------------|----------|-----------------|-----------------|-----------------|
| 1 | DONE | GOE, GWDIS, GSR | | |
| 2 | DONE | | GOE, GWDIS, GSR | |
| 3 | DONE | | | GOE, GWDIS, GSR |
| 4 | DONE | GOE | GWDIS, GSR | |
| 5 | DONE | GOE | | GWDIS, GSR |
| 6 | DONE | GOE | GWDIS | GSR |
| 7 | DONE | GOE | GSR | GWDIS |
| 8 | | DONE | GOE, GWDIS, GSR | |
| 9 | | DONE | | GOE, GWDIS, GSR |
| 10 | | DONE | GWDIS, GSR | GOE |
| 11 | | DONE | GOE | GWDIS, GSR |
| 12 | | | DONE | GOE, GWDIS, GSR |
| 13 | | GOE, GWDIS, GSR | DONE | |
| 14 | | GOE | DONE | GWDIS, GSR |
| 15 | | GOE, GWDIS | DONE | GSR |
| 16 | | GWDIS | DONE | GOE, GSR |
| 17 | | GWDIS, GSR | DONE | GOE |
| 18 | | GOE, GSR | DONE | GWDIS |
| 19 | | | GOE, GWDIS, GSR | DONE |
| 20 | | GOE, GWDIS, GSR | | DONE |
| 21 (Default) | | GOE | GWDIS, GSR | DONE |
| 22 | | GOE, GWDIS | GSR | DONE |
| 23 | | GWDIS | GOE, GSR | DONE |
| 24 | | GWDIS, GSR | GOE | DONE |
| 25 | | GOE, GSR | GWDIS | DONE |

Figure 15-12. Wake-Up Timing Diagram

Synchronizing Wake-Up

The internal Wake-Up sequence clock source can be chosen as well as how the device wakes up relative to other devices.

Wake-Up Clock Selection

The Wake-Up sequence is synchronized to a clock source that is user selectable. The clock sources are External (default) and User Clock.

When External is selected the LatticeECP2/M will use one of two clocks during the Wake-Up sequence, depending on the configuration data source. If the LatticeECP2/M is being configured from JTAG then JTAG's TCK will be used for the Wake-Up sequence, if configuration data is coming from a sysCONFIG port (serial, parallel, or SPI) then CCLK will be used.

When User is selected, any of the clock signals in the design can be used as the clock source.

Synchronous to Internal Done Bit

If the LatticeECP2/M is the only device in the configuration chain, or the last device in the chain, DONE_EX should be set to the default value (OFF). The Wake-Up process will be initiated by setting of the internal Done bit on successful completion of configuration.

Synchronous to External DONE Pin

The DONE pin can be used to synchronize Wake-Up to other devices in the configuration chain. If DONE_EX (see the DONE_OD, DONE_EX section above) is ON then the DONE pin is a bi-directional pin. If an external device drives the DONE pin low then the Wake-Up sequence will be delayed; configuration can complete but Wake-Up is delayed. Once the DONE pin goes high the device will follow the selected WAKE_UP sequence.

In a configuration chain, a chain of devices configuring from one source (such as Figure 15-2), it is usually desirable, or even necessary, to delay wake-up of all of the devices until the last device finishes configuration. This is accomplished by setting DONE_OD to OFF and DONE_EX to OFF on the last device while setting DONE_OD to ON and DONE_EX to ON for the other devices.

Wake-Up Sequence Options

The Wake-Up sequence options shown in Table determine the order of application for three internal signals, GSR, GWDIS, and GOE, and one external signal, DONE.

- GSR is used to set and reset the core of the device. GSR is asserted (low) during configuration and de-asserted (high) in the Wake-Up sequence.

- When the GWDIS signal is low it safeguards the integrity of the RAM Blocks and LUTs in the device. This signal is low before the device wakes up.
- When low, GOE prevents the device's I/O buffers from driving the pins.
- When high, the DONE pin indicates that configuration is complete and that no errors were detected.

If DONE_EX (see DONE_OD, DONE_EX above) is OFF then sequence 21 is the default, but the user can select any sequence from 8 to 25; if DONE_EX is ON the default sequence is 4, but the user can select any sequence from 1 to 7.

Configuration FAQs

Here are some of the more common questions regarding device configuration.

General

- **Q. Other than JTAG, what is the least expensive method of configuration?**
 - A. If you already have a processor and extra storage on the board you can use the processor to feed configuration data to the LatticeECP2/M. The least expensive stand-alone configuration option is SPI Serial Flash.
- **Q. I have created my bitstream, now how do I load the bitstream into the LatticeECP2/M?**
 - A. Use the free Lattice ispVM tool (from www.latticesemi.com), and a Lattice ispDOWNLOAD[®] cable.
- **Q. I can't read the LatticeECP2/M device ID using JTAG. What could be wrong?**
 - A. This is the most basic of JTAG operations. If you are having trouble reading the device ID then something basic is wrong. Check that the JTAG connections are correct, and that V_{CCJ} and the download cable V_{CC} are correct (and the same). Make sure that the XRES pin is connected to ground through a 10K resistor. Check that all LatticeECP2/M V_{CC} and ground pins are properly connected. Check for noise on the JTAG signals. Sometimes touching a properly grounded 'scope probe to TCK will change the symptoms; if so, you have signal noise issues. Check for excessive noise on the V_{CC} pins.
- **Q. Is there anything I can do during board design that will make debugging easier?**
 - A. Bring the dedicated configurations pins, PROGRAMN, INITN, DONE, and CCLK out to accessible test points.
- **Q. Do I need external pull-up resistors on PROGRAMN, INITN, or DONE?**
 - A. All of these signals have internal weak pull-ups, however if you have a noisy environment, or have several devices connected to these pins, adding a 10K pull-up to the signal is recommended.
- **Q. How can I get assistance with configuration issues?**
 - A. Use the On-line Assistant feature in ispVM. You will find it under the Help menu.

Mode Specific

SPI/SPIm

- **Q. How do I program the SPI Serial Flash once it's on the board?**

A. Connect the SPI Serial Flash to the LatticeECP2/M as shown in this document, then use ispVM, and a Lattice ispDOWNLOAD cable connected to the JTAG port, to program the bitstream into the Flash.

LatticeECP2/M devices have a JTAG instruction for programming the SPI Serial Flash. This JTAG instruction connects the JTAG TCK internally to the CCLK which drives the SPI clock during programming. After launching ispVM, click on the **Scan** button to scan the devices in the JTAG chain, select the LatticeECP2/M device, then click **Edit>Edit Device** to launch the Device Information window. In the Device Information window, select **SPI Flash Programming** for the Device Access Options to open the SPI Serial Flash Device window. Select the SPI Serial Flash device and the bitstream data file for programming the SPI Serial Flash.

- **Q. Are there any special requirements for wiring the SPI Flash to the LatticeECP2/M?**

A. Other than connecting the Flash to the right pins the only other suggestion is to add a 4.7K pull-down resistor between CCLK and ground. This keeps CCLK quite during V_{CC} ramp-up.

- **Q. Can I use 2.5V to power the SPI Flash?**

A. Today all SPI Serial Flash of the "25" type are 3.3V, so the Flash, and V_{CCIO8} , must be connected to 3.3V.

- **Q. Can I use something other than a "25" type SPI Serial Flash?**

A. Only devices that recognize a read op-code of 03h may be used with the LatticeECP2/M. Please refer to Table 15-6 for a list of vendors.

- **Q. My design is small, can I use a smaller-than-recommended SPI Flash?**

A. The state of all of the device fuses is contained in the bitstream, whether they are part of the design or not. The size of the design does not affect the size of the bitstream.

Serial

- **Q. Can I use a free running clock for Slave Serial mode?**

A. The LatticeECP2/M clocks data in on every rising edge of CCLK so there should only be one rising clock edge for each data bit.

- **Q. Is the bitstream for the serial modes different from the bitstream for other modes?**

A. All sysCONFIG bitstreams are the same, they can be different file types, such as hex or binary, but the data is the same.

Parallel

- **Q. My processor is generating all of the proper control signals but the LatticeECP2/M won't configure, and INITN goes high and stays high while DONE stays low. What's wrong?**

A. D0 is the MSB and D7 is the LSB. Try reversing the bit order for each byte in the bitstream. You can do this using your processor or you can generate a bit mirrored file using ispVM. Lattice recommends using your processor so that you don't have to remember to bit mirror the file.

Technical Support Assistance

Hotline: 1-800-LATTICE (North America)

+1-503-268-8001 (Outside North America)

e-mail: techsupport@latticesemi.com

Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|---|
| February 2006 | 01.0 | Initial release. |
| February 2006 | 01.1 | Added ECP2-6 to Maximum Configuration Bits table and changed ECP2-22 to ECP2-20. |
| April 2006 | 01.2 | Updated section on SPIm. Also added screen shots to SPIm section. |
| September 2006 | 01.3 | Updated Maximum Configuration Bits table with ECP2M35 data. |
| February 2007 | 01.4 | Updated Maximum Configuration Bits table with ECP2M data. |
| March 2007 | 01.5 | Added information about LatticeECP2/M “S” series to the Dual Boot Image Setup section. |
| April 2007 | 01.6 | Added more information about SPI programming using ispVM to the SPI/SPIm Q&A section. |
| June 2007 | 01.7 | Added hysteresis value. Removed support for booting from multiple SPI Flash devices in the SPIm mode. Added note for SPIFASTN pin. |
| August 2007 | 01.8 | Added sizes for encrypted bitstream files and new conditions for their use. Removed restriction on I/O direction for dual-purpose configuration pins. |
| September 2007 | 01.9 | Updated Configuration Pins text section. Updated PROGRAMN text section. |
| January 2008 | 02.0 | Changed PROGRAMN and INITN pin descriptions. Changed CSN and CS1N pin description. Added CSN and CS1N pin restrictions in Slave Parallel Mode section. |
| September 2008 | 02.1 | Updated CCLK text section. |
| June 2010 | 02.2 | Updated document for Lattice Diamond design software support. |
| March 2011 | 02.3 | Added information for 100-pin TQFP and 208-pin PQFP device configuration limitations. Added notes to the Dual-purpose sysCONFIG pins section for CSN and CS1N, and WRITEN. Added note to the Slave Parallel Mode section for CSN and CS1N and WRITEN. |

Appendix A. Lattice Diamond Usage Overview

This appendix discusses the use of Lattice Diamond design software for projects that include the LatticeECP2M SERDES/PCS module .

For general information about the use of Lattice Diamond, refer to the Lattice Diamond Tutorial.

If you have been using ispLEVER software for your FPGA design projects, Lattice Diamond may look like a big change. But if you look closer, you will find many similarities because Lattice Diamond is based on the same toolset and work flow as ispLEVER. The changes are intended to provide a simpler, more integrated, and more enhanced user interface.

Converting an ispLEVER Project to Lattice Diamond

Design projects created in ispLEVER can easily be imported into Lattice Diamond. The process is automatic except for the ispLEVER process properties, which are similar to the Diamond strategy settings, and PCS modules. After importing a project, you need to set up a strategy for it and regenerate any PCS modules.

Importing an ispLEVER Design Project

Make a backup copy of the ispLEVER project or make a new copy that will become the Diamond project.


1. In Diamond, choose **File > Open > Import ispLEVER Project**.
2. In the ispLEVER Project dialog box, browse to the project's .syn file and open it.
3. If desired, change the base file name or location for the Diamond project. If you change the location, the new Diamond files will go into the new location, but the original source files will not move or be copied. The Diamond project will reference the source files in the original location.

The project files are converted to Diamond format with the default strategy settings.

Adjusting PCS Modules

PCS modules created with IPexpress have an unusual file structure and need additional adjustment when importing a project from ispLEVER. There are two ways to do this adjustment. The preferred method is to regenerate the module in Diamond. However this may upgrade the module to a more recent version. An upgrade is usually desirable but if, for some reason, you do not want to upgrade the PCS module, you can manually adjust the module by copying its .txt file into the implementation folder. If you use this method, you must remember to copy the .txt file into any future implementation folders.

Regenerate PCS Modules

1. Find the PCS module in the Input Files folder of File List view. The module may be represented by an .lpc, .v, or .vhd file.
2. If the File List view shows the Verilog or VHDL file for the module, and you want to regenerate the module, import the module's .lpc file:
 - a. In the File List view, right-click the implementation folder () and choose **Add > Existing File**.
 - b. Browse for the module's .lpc file, **<module_name>.lpc**, and select it.
 - c. Click **Add**. The .lpc file is added to the File List view.
 - d. Right-click the module's Verilog or VHDL file and choose **Remove**.
3. In File List, double-click the module's .lpc file. The module's IPexpress dialog box opens.
4. In the bottom of the dialog box, click **Generate**. The Generate Log tab is displayed. Check for errors and close.

In File List, the .lpc file is replaced with an .lpx file. The IPexpress manifest (.lpx) file is new with Diamond. The .lpx file keeps track of the files needed for complex modules.

Using IPexpress with Lattice Diamond

Using IPexpress with Lattice Diamond is essentially same as with ispLEVER.

The configuration GUI tabs are all the same except for the Generation Options tab. Figure 15-13 shows the Generation Options tab window.

Figure 15-13. Generation Options Tab



Table 15-10. SERDES_PCS GUI Attributes – Generation Options Tab

| GUI Text | Description |
|---|---|
| Automatic | Automatically generates the HDL and configuration(.txt) files as needed. Some changes do not require regenerating both files. |
| Force Module and Settings Generation | Generates both the HDL and configuration files. |
| Force Settings Generation Only | Generates only the attributes file. You get an error message if the HDL file also needs to be generated. |
| Force Place & Route Process Reset | Resets the Place & Route Design process, forcing it to be run again with the newly generated PCS module. |
| Force Place & Route Trace Process Reset | Resets the Place & Route Trace process, forcing it to be run again with the newly generated PCS module. |

Note:

Automatic is set as the default option. If either Automatic or Force Settings Generation Only and no sub-options (Process Reset Options) are checked and the HDL module is not generated, the reset pointer is set to Bitstream generation automatically.

After the Generation is finished, the reset marks in the process window will be reset accordingly.

Creating a New Simulation Project Using Simulation Wizard

This section describes how to use the Simulation Wizard to create a simulation project (.spf) file so you can import it into a standalone simulator.

1. In Project Navigator, click **Tools > Simulation Wizard**. The Simulation Wizard opens.
2. In the Preparing the Simulator Interface page click **Next**.
3. In the Simulator Project Name page, enter the name of your project in the Project Name text box and browse to the file path location where you want to put your simulation project using the Project Location text box and Browse button.

When you designate a project name in this wizard page, a corresponding folder will be created in the file path you choose. Click **Yes** in the popup dialog that asks you if you wish to create a new folder.

4. Click either the Active-HDL[®] or ModelSim[®] simulator check box and click **Next**.
5. In the Process Stage page choose which type of Process Stage of simulation project you wish to create. Valid types are RTL, Post-Synthesis Gate-Level, Post-Map Gate-Level, and Post-Route Gate-level+Timing. Only those process stages that are available are activated.

Note that you can make a new selection for the current strategy if you have more than one defined in your project.

The software supports multiple strategies per project implementation which allow you to experiment with alternative optimization options across a common set of source files. Since each strategy may have been processed to different stages, this dialog allows you to specify which stage you wish to load.

6. In the Add Source page, select from the source files listed in the Source Files list box or use the browse button on the right to choose another desired source file. Note that if you wish to keep the source files in the local simulation project directory you just created, check the **Copy Source to Simulation Directory** option.
7. Click **Next** and a Summary page appears and provides information on the project selections including the simulation libraries. By default, the Run Simulator check box is enabled and will launch the simulation tool you chose earlier in the wizard in the Simulator Project Name page.
8. Click **Finish**.

The Simulation Wizard Project (.spf) file and a simulation script DO file are generated after running the wizard. You can import the DO file into your current project if desired. If you are using Active-HDL, the wizard will generate an .ado file and if you are using ModelSim, it creates and .mdo file.

Note: PCS configuration file, (.txt) must be added in step 6.

Setting Global Preferences in Diamond

To set any of the Global preferences in Table 15-11, do the following in Diamond:

- Invoke the Spreadsheet View by selecting **Tools > Spreadsheet View**.
- Select the **Global Preferences Tab** beneath the Spreadsheet View pane as shown in Figure 15-14.
- Right-click on the **Preference Value** to be set. In the drop-down menu, select the desired value.

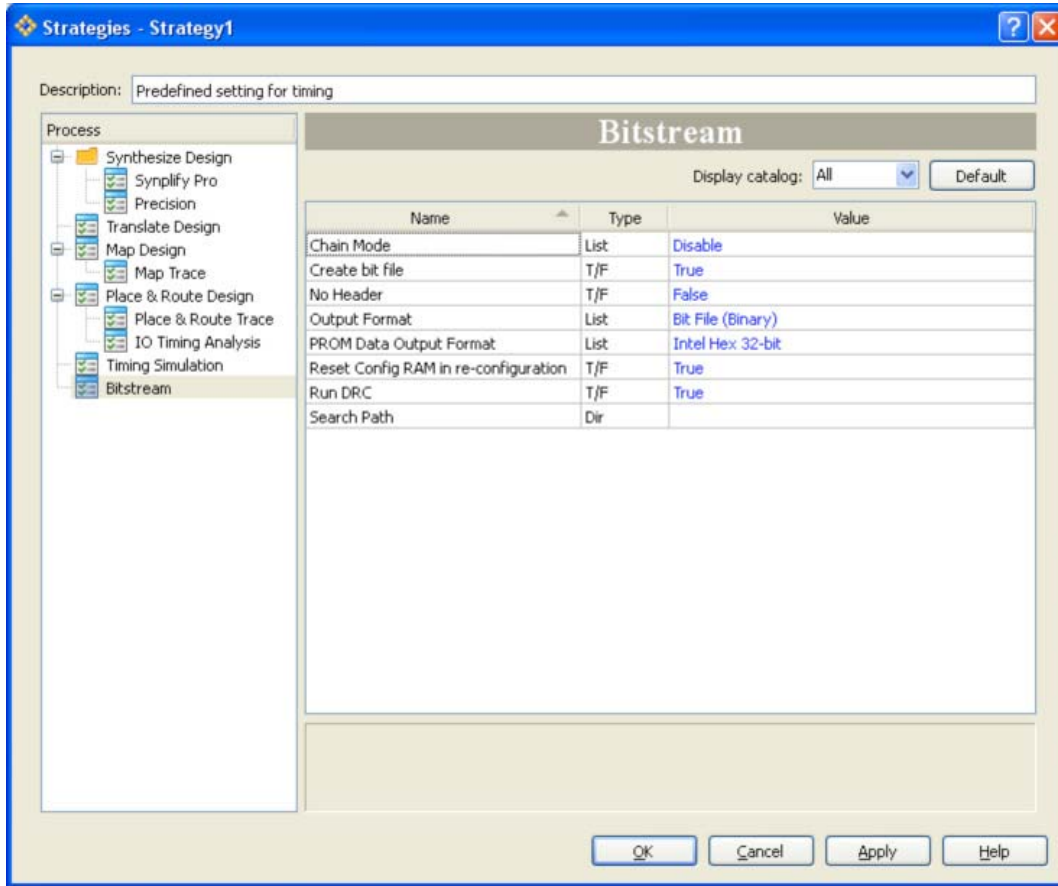
Table 15-11. Global Preferences

| Preference Name | Values |
|-----------------|---|
| PERSISTENT | ON Off |
| CONFIG_MODE | SLAVE_SERIAL JTAG NONE SLAVE_PARALLEL SPI SPIm |
| DONE_OD | ON Off |
| DONE_EX | OFF |
| MCCLK_FREQ | 2.5 5.4 10 34 41 45 |
| CONFIG_SECURE | OFF ON |
| WAKE_UP | An integer between 1 and 25 |
| COMPRESS_CONFIG | OFF ON |
| INBUF | OFF ON |
| ENABLE_NDR | OFF ON |

Table 15-12. Bitstream Generation Options

| Preference Name | Values |
|--------------------------------------|---|
| Chain Mode | Disable (default) Bypass Flowthrough |
| Create bit file | True |
| No Header | True False |
| Output Format | Bit File (Binary) Mask and Readback File (ASCII) Mask and Radback File (Binary) Raw Bit file (ASCII) |
| PROM Data Output Format | Intel Hex 32-bit Motorola Hex 32-bit |
| Reset Config RAM in re-configuration | True False |
| Run DRC | True False |
| Search Path | Enter a value or browse to specify the search path |

Figure 15-15. Setting Bitstream Options in Diamond



- Double-click the left mouse button on the **Value** you want to set. Select the desired value from the drop-down menu.

*Note: An explanation of the option is displayed at the bottom of the window. The **Help** button also invokes online help for the option*

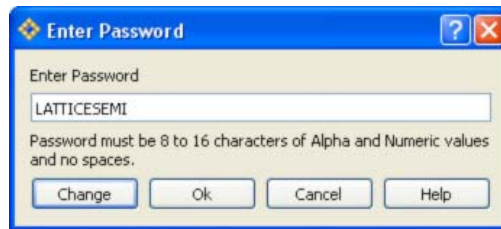
- Select **OK**. You can then run the Bitstream File process.

Setting Security Options in Diamond

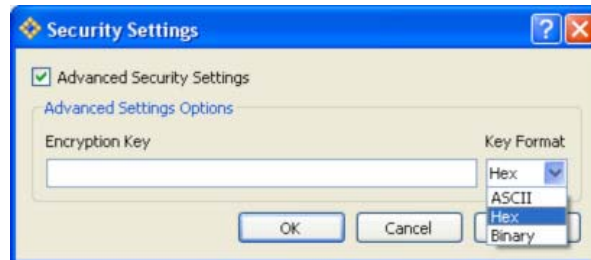
Prior to setting security options in Diamond, you must have installed the Encryption Control Pack. You must also have selected an encrypted device in your project.

To Set Security Settings, do the following:

- Select the **Tools > Security Setting** option. The following dialog box appears:



- If desired, select **Change** and enter a password.
- Select **OK**. A dialog window appears to enter an encryption key.
- If you do not want to enable an encryption key, select **OK**.
- If you do want to enable an encryption key, select the **Advanced Security Settings** checkbox, enter the **Key Format**, and then enter the **Encryption Key**.



- Select **OK** to create the encryption files.

Introduction

All Lattice FPGAs provide configuration data read security, meaning that a fuse can be set so that when the device is read all zeros will be output instead of the actual configuration data. This kind of protection is common in the industry and provides very good security if the configuration data storage is on-chip, such as with the LatticeXP™ and MachXO™ device families. However, if the configuration bitstream comes from an external boot device it is quite easy to read the configuration data, allowing access to the FPGA design.

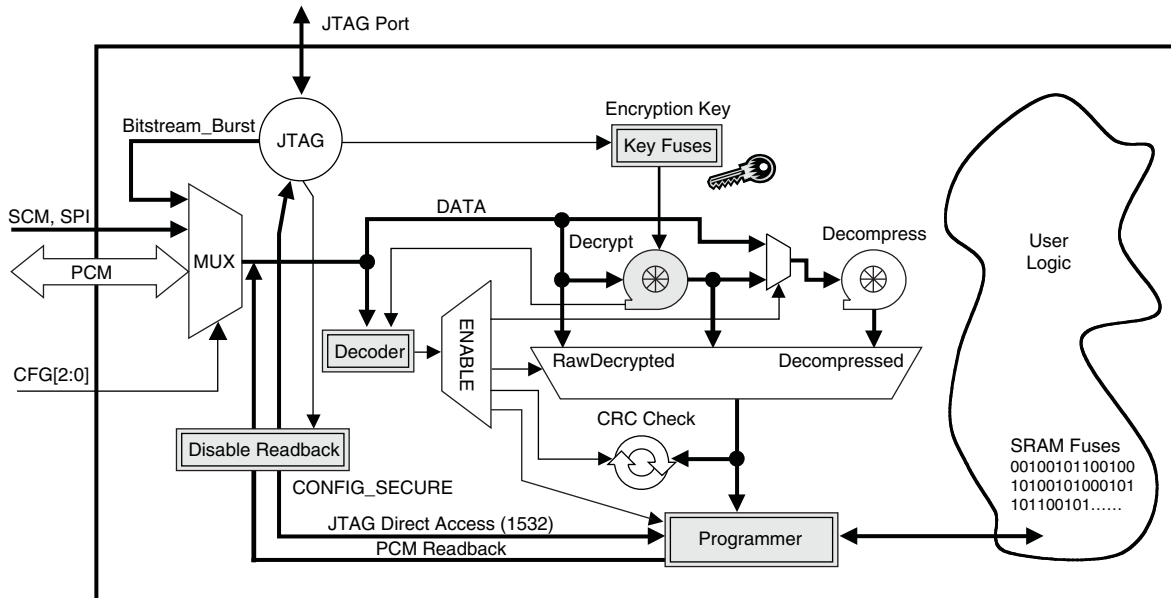
For this reason the “S” versions of LatticeECP2™ and LatticeECP2M™ offer the 128-bit Advanced Encryption Standard (AES) to protect the bitstream. The user selects and has total control over the 128-bit key and no special voltages are required to maintain the key within the FPGA.

This document explains the capabilities of this new security feature and how to take advantage of it.

General Configuration Process

Figure 16-1 is a block diagram describing the LatticeECP2/M “S” version bitstream encryption data paths. Refer to this figure as you read the following sections.

Figure 16-1. LatticeECP2/M “S” Version Bitstream Encryption Block Diagram



Lattice FPGAs are configured by using the sysCONFIG™ interface or the JTAG interface (see Table 16-1).

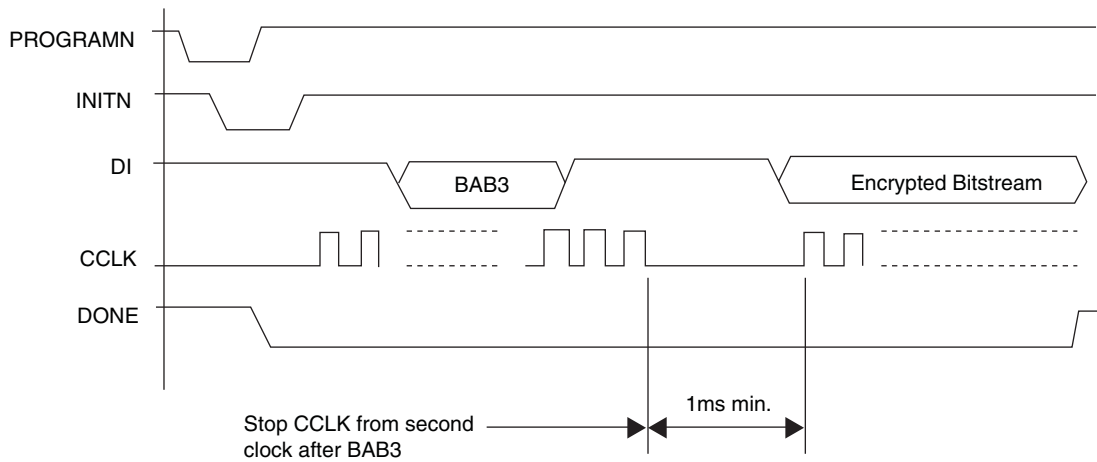
Table 16-1. Configuration Ports

| Interface | Port |
|-----------|---|
| sysCONFIG | SPI ¹ |
| | SPI _m ¹ |
| | Slave Serial (SCM) ² |
| | Slave Parallel (PCM) ² |
| ispJTAG™ | IEEE 1532 (Erase, Program, Verify) ³ |
| | Bitstream Burst (Fast Program) |

1. Supports subset of the CCLK frequencies specified in the [LatticeECP2/M Family Data Sheet](#).
2. Users must adhere to the appropriate conditions for the CCLK signal as described below.
3. Does not support encrypted bitstreams.

The sysCONFIG interface allows the user to input data serially, using serial configuration mode (SCM) or SPI Serial Flash, or in parallel, using the parallel configuration mode (PCM). In general, the connection between the FPGA and the configuration device consists of a clock, chip select(s), a write signal (in PCM), and data. During configuration all data written to the FPGA is ignored until a special preamble is detected in the bitstream. Everything after the preamble is configuration data. The normal preamble is BAB3 (hex), however encrypted bitstreams contain a different preamble. When using SCM mode, any CCLK frequencies from 2.5MHz to 45MHz are supported but it is required to stop the CCLK after loading the BAB3 (hex) encryption preamble as shown below.

Figure 16-2. CCLK Timing



To ensure proper programming when using encrypted bitstreams in SPI mode only a subset of CCLK frequencies are supported. The supported frequencies are shown in the [LatticeECP2/M Family Data Sheet](#).

The JTAG port, which conforms to IEEE 1149.1 and IEEE 1532 standards, can input data in Bitstream-Burst mode (Fast Program) or 1532 mode. Configuration bitstreams created for Bitstream-Burst mode (Fast Program) are identical to the configuration bitstreams created for sysCONFIG mode. The bitstream contains a header, a preamble, configuration data, and frame data CRC. However, 1532 mode makes use of standard JTAG instructions to configure the device. In other words, the configuration data file contains configuration data only. Because 1532 mode data files do not contain a preamble, they cannot be used to input encrypted configuration files.

In addition to being a configuration interface, JTAG also allows the user to program the 128-bit encryption key. In fact, JTAG is the only way to program the key.

For detailed information on LatticeECP2/M configuration including bitstream file sizes, refer to TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#). Note that bitstream sizes vary depending on the configuration mode.

Bitstream Encryption/Decryption Flow

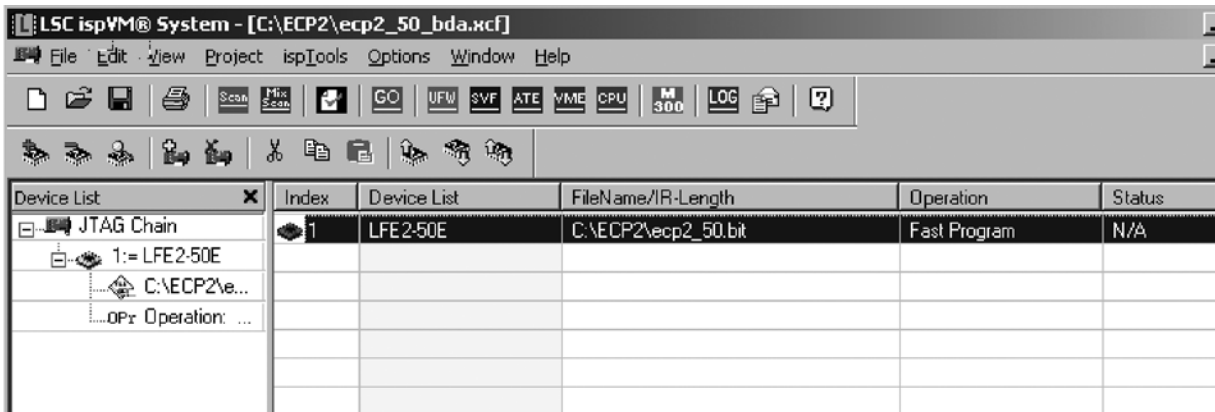
The LatticeECP2/M “S” versions support both encrypted and non-encrypted bitstreams. Since the non-encrypted flow is covered in TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#), this document will concentrate on the additional steps needed for the encrypted flow. The encrypted flow adds only two steps to the normal FPGA design flow, encryption of the configuration bitstream and programming the encryption key into the LatticeECP2/M “S” version devices.

Encrypting the Bitstream

As with any other Lattice FPGA design flow, the engineer must first create the design using a version of ispLEVER® or Lattice Diamond™ design software which supports the encryption feature. You may need to request the Encryption Installer to enable access to the additional encryption software. The design is synthesized, mapped, placed and routed, and verified. Once the engineer is satisfied with the design a bitstream is created and loaded into the FPGA for final debug. After the design has been debugged it is time to secure the design.

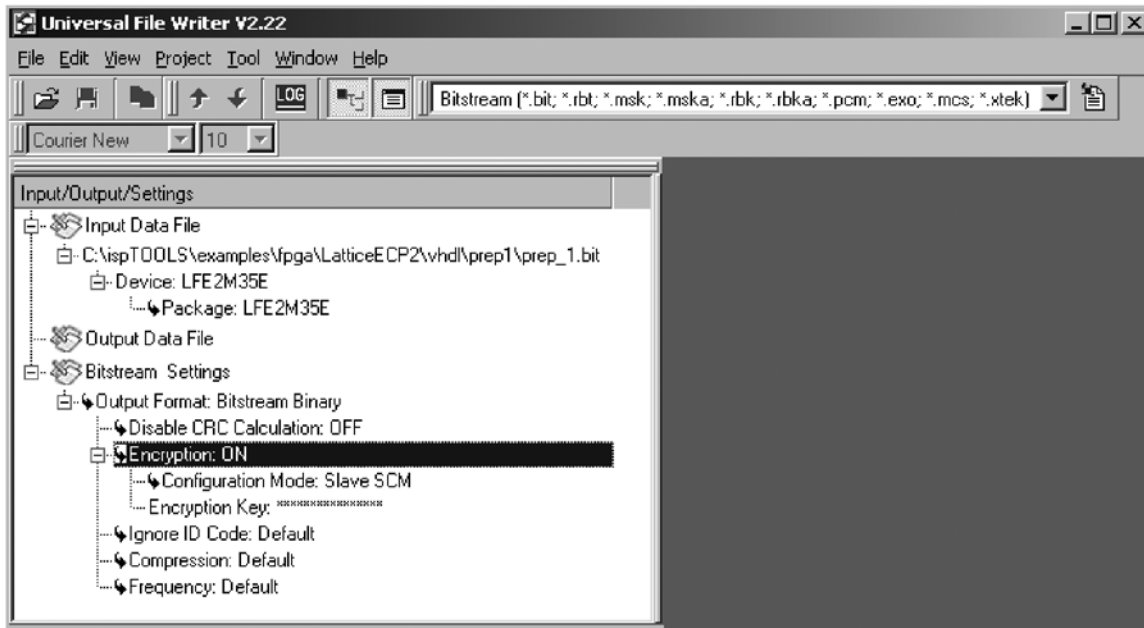
The bitstream can be encrypted using an appropriate version of ispLEVER by going to the Tools pull-down menu and selecting Security features or by using the Universal File Writer (UFW), which is part of the Lattice ispVM® System tool suite. The file is encrypted using ispVM as follows. To encrypt a bitstream in Diamond, refer to Appendix A.

Figure 16-3. ispVM Main Window



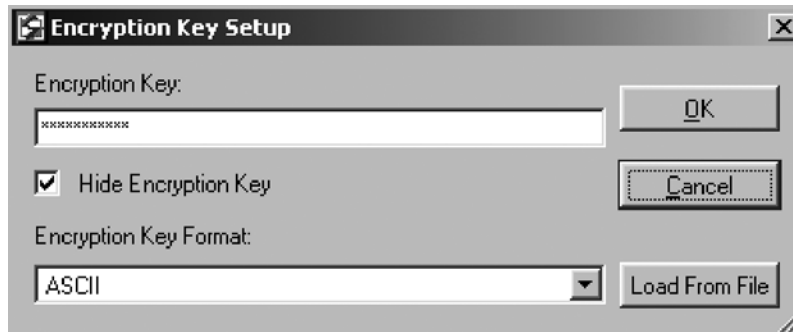
1. Start ispVM. You can start ispVM from within ispLEVER or from the **Start -> Programs** menu in Windows. You should see a window that looks similar to Figure 16-3. Click on the **UFW** button on the toolbar. You will see a window similar to Figure 16-4. ispVM cannot be invoked within Diamond.

Figure 16-4. Universal File Writer (Encryption Option)



2. Double click on **Input Data File** and browse to the non-encrypted bitstream created in ispLEVER or Diamond. Double-click on **Output Data File** and select an output file name. Right-click on **Encryption** and select **ON**. Right-click on **Configuration Mode** and select the type of device the FPGA will be configuring from, such as SPI Serial Flash. Right-click on **Encryption Key** and select **Edit Encryption Key**. You will see a window that looks similar to Figure 16-5.

Figure 16-5. Encryption Key Dialog Window



3. Enter the desired 128-bit key. The key can be entered in Hexadecimal or ASCII. Hex supports 0 through f and is not case sensitive. ASCII supports all alphanumeric characters, as well as spaces, and is case sensitive. Note: be sure to remember this key. Lattice cannot recover an encrypted file if the key is lost. Click on **OK** to go back to the main UFW window.
4. From the menu bar, click on **Project -> Generate** to create the encrypted bitstream file.
5. The bitstream can now be loaded directly into non-volatile configuration storage (such as SPI Serial Flash) using a Lattice ispDOWNLOAD® Cable, a third-party programmer, or any other method normally used to program a non-encrypted bitstream. However, before the LatticeECP2/M can configure from the encrypted file the 128-bit key used to encrypt the file must be programmed into the one-time programmable fuses on the FPGA.

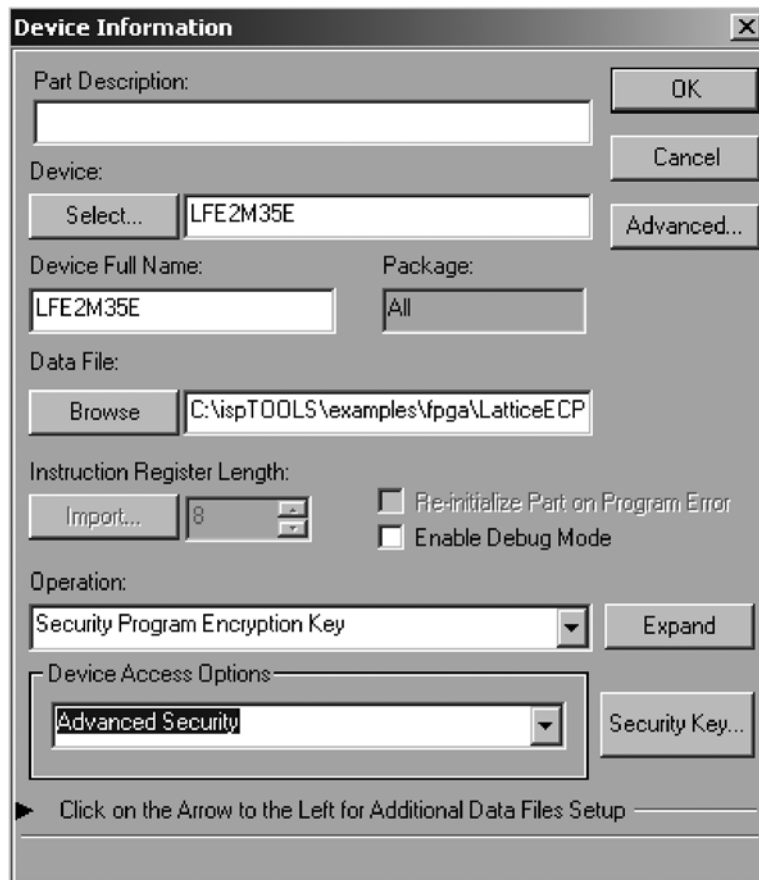
Programming the 128-bit Key

The next step is to program the 128-bit encryption key into the one-time programmable fuses on the LatticeECP2/M. Note that this step is separated from file encryption to allow flexibility in the manufacturing flow. For instance, the board manufacturer might program the encrypted file into the SPI Serial Flash, but the key might be programmed at the user’s facility. This flow adds to design security and it allows the user to control over-building of a design. Over-building occurs when a third party builds more boards than are authorized and sells them to grey market customers. If the key is programmed at the factory, then the factory controls the number of working boards that enter the market. The LatticeECP2/M “S” version will only configure from a file that has been encrypted with the same 128-bit key that is programmed into the FPGA.

To program the key into the LatticeECP2/M “S” version, proceed as follows.

1. Attach a Lattice ispDOWNLOAD cable from a PC to the JTAG connector wired to the LatticeECP2/M (note that the 128-bit key can only be programmed into the LatticeECP2/M using the JTAG port). Apply power to the board.
2. Start the ispVM System software. ispVM can be started from within the ispLEVER design tool (ispVM cannot be invoked from within Diamond) or from the **Start -> Programs** menu in Windows. You should see a window that looks similar to Figure 16-3. If the window does not show the board’s JTAG chain then proceed as follows. Otherwise, proceed to step 3.
 - a. Click the **SCAN** button in the toolbar to find all Lattice devices in the JTAG chain. The chain shown in Figure 16-3 has only one device, the LatticeECP2.

Figure 16-6. Device Information Window (Encryption Option)



- Double-click on the line in the chain containing the LatticeECP2. This will open the Device Information window (see Figure 5). From the Device Access Options drop-down box select **Security Mode**, then click on the **Security Key** button to the right. The window will look similar to Figure 16-7.

Figure 16-7. Enter the Encryption Key

- Enter the desired 128-bit key. The key can be entered in Hexadecimal or ASCII. Hex supports 0 through f and is not case sensitive. ASCII supports all alphanumeric characters, as well as spaces, and is case sensitive. This key must be the same as the key used to encrypt the bitstream. The LatticeECP2/M will only configure from an encrypted file whose encryption key matches the one loaded into the FPGA's one-time programmable fuses. *Note: be sure to remember this key. Once the Key Lock is programmed, Lattice Semiconductor cannot read back the one-time programmable key.*
 - The key can be saved to a file using the **Save to File** button. The key will be encrypted using an 8-character password that the user selects. The name of the file will be <project_name>.bek. In the future, instead of entering the 128-bit key, simply click on **Load from File** and provide the password.
- Programming the Key Lock secures the 128-bit encryption key. Once the Key Lock is programmed and the device is power cycled, the 128-bit encryption key cannot be read out of the device. When satisfied, type **Yes** to confirm, then click **Apply**.
- From the main ispVM window (Figure 16-3) click on the green **GO** button on the toolbar to program the key into the LatticeECP2/M one-time programmable fuses. When complete, the LatticeECP2/M will only configure from a bitstream encrypted with a key that exactly matches the one just programmed.

Verifying a Configuration

As an additional security step when an encrypted bitstream is used, the readback path from the SRAM fabric is automatically blocked. In this case, for all ports, a read operation will produce all zeros. However, even when the configuration bitstream has been encrypted and readback disabled, there are still ways to verify that the bitstream was successfully downloaded into the FPGA.

If the SRAM fabric is programmed directly, the data is first decrypted and then the FPGA performs a CRC on the data. If all CRCs pass, configuration was successful. If a CRC does not pass, the DONE pin will stay low and INITN will go from high to low (for more information on this type of error, refer to TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#)).

If the encrypted data is stored in non-volatile configuration memory, such as SPI Serial Flash, the data is stored encrypted. A bit-for-bit verify can be performed between the encrypted configuration file and the stored data.

File Formats

The base binary file format is the same for all non-encrypted, non-1532 configuration modes. Different file types (hex, binary, ASCII, etc.) may ultimately be used to configure the device, but the data in the file is the same. Table 16-2 shows the format of a non-encrypted bitstream. The bitstream consists of a comment field, a header, the preamble, and the configuration setup and data.

Table 16-2. Non-Encrypted Configuration Data

| Frame | Contents | Description |
|--------------------|------------------|--|
| Comments | (Comment String) | ASCII Comment (Argument) String and Terminator |
| Header | 1111...1111 | 16 Dummy bits |
| | 1011110110110011 | 16-bit Standard Bitstream Preamble (0xBDB3) |
| Verify ID | | 64 bits of command and data |
| Control Register 0 | | 64 bits of command and data |
| Reset Address | | 32 bits of command and data |
| Write Increment | | 32 bits of command and data |
| Data 0 | | Data, 16-bit CRC, and Stop bits |
| Data 1 | | Data, 16-bit CRC, and Stop bits |
| . | . | . |
| . | . | . |
| . | . | . |
| Data n-1 | | Data, 16-bit CRC, and Stop bits |
| End | 1111...1111 | Terminator bits and 16-bit CRC |
| Usercode | | 64 bits of command and data |
| SED CRC | | 64 bits of command and data |
| Program Security | | 32 bits of command and data |
| Program Done | | 32 bits of command and data, 16-bit CRC |
| NOOP | 1111...1111 | 64 bits of NOOP data |
| End | 1111...1111 | 32-bit Terminator (all ones) |

Note: The data in this table is intended for reference only.

Table 16-3 shows a bitstream that is built for encryption but has not yet been encrypted. The highlighted areas will be encrypted. The changes between Table 16-2 and Table 16-3 include the following:

- The Program Security frame (readback disable) has been moved to the beginning of the file so that readback is turned off at the very beginning of configuration. This is an important security feature that prevents someone from interrupting the configuration before completion and reading back unsecured data.
- A copy of the usercode is placed in the non-encrypted comment string. This has been done to allow the user a method to identify an encrypted file. For example, the usercode could be used as a file index or a “hint”. Note that the usercode itself, while encrypted in the configuration data file, is not encrypted on the device. At configuration the usercode is decrypted and placed in the JTAG Usercode register. This allows the user a method to identify the data in the device. The JTAG Usercode register can be read back at any time, even when all SRAM readback paths have been turned off. The usercode can be set to any 32-bit value. For information on how to set usercode, see the ispLEVER or Diamond help facility.
- A copy of CONFIG_MODE, one of the global preferences, is placed in the non-encrypted comment string. CONFIG_MODE can be SPI/SPIm, Slave SCM, or Slave PCM.

Note that if the global COMPRESS_CONFIG option is turned ON using ispLEVER Design Planner or UFW, data compression will be performed before encryption. To set this configuration option in Diamond, see Appendix A.

Table 16-3. Configuration File Just Before Encryption

| Frame | Contents | Description |
|--------------------|------------------|--|
| Comments | (Comment String) | ASCII Comment (Argument) String and Terminator |
| Header | 1111...1111 | 16 Dummy Bits |
| | | 16-bit Standard Bitstream Preamble |
| Verify ID | | 64 bits of Command and Data |
| Control Register 0 | | 64 bits of Command and Data |
| Program Security | | 32 bits of Command and Data |
| Reset Address | | 32 bits of Command and Data |
| Write Increment | | 32 bits of Command and Data |
| Data 0 | | Data, 16-bit CRC, and Stop Bits |
| Data 1 | | Data, 16-bit CRC, and Stop Bits |
| . | . | . |
| . | . | . |
| . | . | . |
| Data n-1 | | Data, 16-bit CRC and Stop Bits |
| End | 1111...1111 | Terminator Bits and 16-bit CRC |
| Usercode | | 64 Bits of Command and Data |
| SED CRC | | 64 Bits of Command and Data |
| Program Done | | 32 Bits of Command and Data, 16-bit CRC |
| NOOP | 1111...1111 | 64 bits of NOOP data |
| End | 1111...1111 | 32-bit Terminator (All Ones). |

Note: The data in this table is intended for reference only. The shaded areas will be encrypted.

Once encrypted, besides the obvious encryption of the data itself, the file will have additional differences from a non-encrypted file (refer to Tables 16-4, 16-5, and 16-6).

- There are three preambles, the encryption preamble, alignment preamble, and the bitstream preamble. The alignment preamble marks the beginning of the encrypted data. The entire original bitstream, including the bitstream preamble are all encrypted, per Table 16-3. The comment string, the encryption preamble, dummy data, and alignment preamble are not encrypted.
- The decryption engine within the FPGA takes some time to perform its task; extra time is provided in one of two ways. For master configuration modes (SPI and SPIm) the FPGA drives the configuration clock, so when extra time is needed the FPGA stops sending configuration clocks. For slave configuration modes (Bitstream-Burst, Slave Serial, and Slave Parallel) the data must be padded to create the extra time. Because of this there are several different file formats for encrypted data (see Tables 16-4, 16-5, and 16-6). Note that because of the time needed to decrypt the bitstream it takes longer to configure from an encrypted data file than it does from a non-encrypted file. The bitstream sizes may vary depending on the configuration mode. For exact file sizes, refer to TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#).

Table 16-4. Encrypted File Format for a Master Mode

| Frame | Contents | Description |
|--------------------|------------------|--|
| Comments | (Comment String) | ASCII Comment (Argument) String and Terminator. |
| Header | 1111...1111 | 16 Dummy bits. |
| | | 16-bit Encryption Preamble. |
| 30,000 Filler Bits | | This allows time for the device to load and hash the 128-bit encryption key. |
| Alignment Preamble | | 16-bit Alignment Preamble. |
| | 1 | 1-bit Dummy Data. |
| Data | | There are no dummy filler bits when the bitstream is generated for master programming modes. The CCLK of the master device stops the clock when it needs time to decrypt the data. It resumes the clock when ready for new data - Encrypted. |
| Program Done | | 32-bit Program Done Command - Encrypted. |
| End | 1111...1111 | 32-bit Terminator (all ones) - Encrypted. |
| Filler Bits | | Filler to meet the bound requirement. |
| Dummy Data | 1111...1111 | 200 bits of Dummy Data (all ones). Provides a delay to turn off the decryption engine. |

Note: The data in this table is intended for reference only. The shaded area is encrypted data.

Table 16-5. Encrypted File Format for a Slave Serial Mode

| Frame | Contents | Description |
|--------------------|------------------|--|
| Comments | (Comment String) | ASCII Comment (Argument) String and Terminator. |
| Header | 1111...1111 | 2 Dummy Bytes. |
| | | 16-bit Encryption Preamble |
| 30,000 Filler Bits | | This allows time for the device to load and hash the 128-bit encryption key. |
| Alignment Preamble | | 16-bit Alignment Preamble. |
| | 1 | 1-bit Dummy Data. |
| Data | | 128 bits of Configuration Data. |
| | | 64 bits of all ones data. Provides a delay for the decryption engine to decrypt the 128 bits of data just received. If the peripheral device can provide the needed 64 clocks while pausing data, then the 64 bits of dummy data are not required, saving file size. |
| | ... | |
| | | Last 128 bits of the last Frame of Configuration Data. |
| | | 64 bits of all ones data. Provides a delay for the decryption engine to decrypt the 128 bits of data just received. If the peripheral device can provide the needed 64 clocks while pausing data, then the 64 bits of dummy data are not required, saving file size. |
| Program Done | | 32-bit Program Done Command - Encrypted. |
| End | | 32-bit Terminator (all ones) - Encrypted. |
| Filler Bits | | Filler to meet the bound requirement. |
| Delay | | 64 bits of all ones data. Delay to decrypt the Program Done command and the filler. |
| Dummy Data | 1111...1111 | 200 bits of Dummy Data (all ones), to provide delay to turn off the decryption engine. |

Note: The data in this table is intended for reference only. The shaded area is encrypted data.

Table 16-6. Encrypted File Format for a Slave Parallel Mode

| Frame | Contents | Description |
|---------------------|------------------|---|
| Comments | (Comment String) | ASCII Comment (Argument) String and Terminator. |
| Header | 1111...1111 | 2 Dummy Bytes. |
| | | 2-byte Encryption Preamble. |
| 30,000 Filler Bytes | | This allows time for the device to load and hash the 128-bit encryption key. |
| Alignment Preamble | | 2-byte Alignment Preamble. |
| | 11111111 | 1-byte Dummy Data. |
| Data | | 16 bytes of Configuration Data. |
| | | 64 bytes (clocks) of all ones data. Provides a delay for the decryption engine to decrypt the 16 bytes of data just received. If the peripheral device can provide the needed 64 clocks while pausing data, then the 64 bytes of dummy data are not required, saving file size. |
| | ... | |
| | | 16 bytes of Configuration Data. |
| | | 64 bytes (clocks) of all ones data. Provides a delay for the decryption engine to decrypt the 16 bytes of data just received. If the peripheral device can provide the needed 64 clocks while pausing data, then the 64 bytes of dummy data are not required, saving file size. |
| Program Done | | 4-byte Program Done Command - Encrypted. |
| End | | 4-byte Terminator (all ones) - Encrypted. |
| Filler Bits | | Filler to meet the bound requirement. |
| Delay | | 64 bytes of all ones data. Delay to decrypt the Program Done command and the filler. |
| Dummy Data | 1111...1111 | 200 bytes of Dummy Data (all ones), to provide delay to turn off the decryption engine. |

Note: The data in this table is intended for reference only. The shaded area is encrypted data.

Decryption Flow

From the user's point of view, as compared to the encryption flow just discussed, the decryption flow is much simpler.

When data comes into the FPGA the decoder starts looking for the preamble (see Figure 16-1) and all information before the preamble is ignored. The preamble, along with the compression bit in Control Register 0, determines the path of the configuration data.

If the decoder detects a standard bitstream preamble in the bitstream it knows that this is a non-encrypted data file. The decoder then examines Control Register 0 in the bitstream to determine if the file has been compressed. If the file has not been compressed then the Raw data path is selected (see Figure 16-1). If the file has been compressed then the Decompressed path is selected; CRC is then checked and the SRAM fuses programmed.

If the decoder detects an encryption preamble in the bitstream it knows that this is an encrypted data file. If an encryption key has not been programmed, the encrypted data is blocked and configuration fails (the DONE pin stays low), if the proper key has been programmed then configuration can continue. The next block read contains 30,000 clocks of filler data. This delay allows time for the FPGA to read the key fuses and prepare the decryption engine. The decoder keeps reading the filler data looking for the alignment preamble. Once found, it knows that the following data needs to go through the decryption engine. It first looks for the standard preamble. Once found, then it reads the Control Register 0 frame. The decoder then examines the decrypted Control Register 0 contents to determine if the file has been compressed. If the file has not been compressed then the Decrypted data path is used, if the file has been compressed then the decrypted data is passed through the decompression engine and the Decompressed path is selected (refer to the block diagram, Figure 16-1). CRC is then checked and the SRAM fuses programmed once the bitstream preamble is read. The decryption and decompression engines are turned off

when the internal Done bit is set at the end of configuration. This is done so that if there is any data overflow (to other devices in a chain) the downstream devices will receive raw data from configuration storage.

But what happens if the key in the FPGA does not match the key used to encrypt the file? Once the data is decrypted, the FPGA expects to find a valid standard bitstream preamble (BDB3), along with proper commands and data that pass CRC checks. If the keys do not match then the decryption engine will not produce a proper configuration bitstream; either configuration will not start because the preamble was not found (the INITN pin stays high and the DONE pin stays low) or CRC errors will occur, causing the INITN pin to go low to indicate the error (see TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#), for more information on INITN and DONE).

References

- TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#)
- Federal Information Processing Standard Publication 197, Nov. 26, 2001. Advanced Encryption Standard (AES)

Technical Support Assistance

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Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|--|
| April 2006 | 01.0 | Initial release. |
| September 2006 | 01.1 | Added information throughout for LatticeECP2M support. |
| | | Updated screen shots based on the latest software version. |
| | | Provided clarification in Table 1. |
| | | Changed Bitstream Preamble to Alignment Preamble through out the document. |
| | | Reworded sections of the document to provide additional information/clarification. |
| March 2007 | 01.2 | Added "S" series encryption information throughout. |
| August 2007 | 01.3 | Updated for "S" series reduced frequency support and special requirement for CCLK and TCK on LatticeSCM, and PCM and JTAG configuration modes. |
| June 2010 | 01.4 | Updated for Lattice Diamond design software support. |

Appendix A. Lattice Diamond Usage Overview

Setting Global Preferences in Diamond

To set any of the Global preferences in Table 16-7, do the following in Diamond:

- Invoke the Spreadsheet View by selecting **Tools > Spreadsheet View**.
- Select the **Global Preferences Tab** beneath the Spreadsheet View pane as shown in Figure 16-8.
- Right-click on the **Preference Value** to be set. In the drop-down menu, select the desired value.

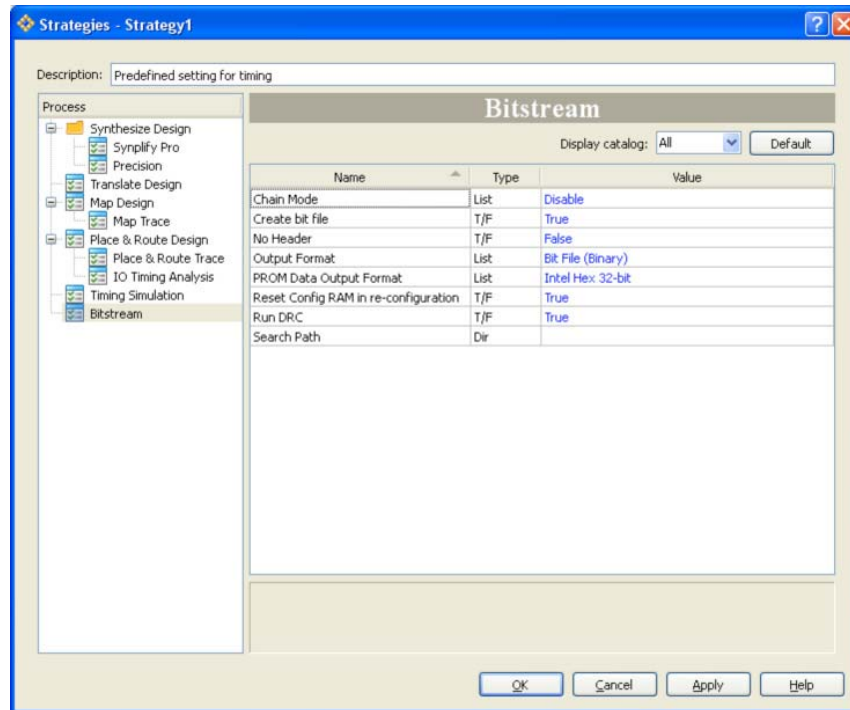
Table 16-7. Global Preferences

| Preference Name | Values |
|-----------------|---|
| PERSISTENT | ON Off |
| CONFIG_MODE | SLAVE_SERIAL JTAG NONE SLAVE_PARALLEL SPI SPIm |
| DONE_OD | ON Off |
| DONE_EX | OFF |
| MCCLK_FREQ | 2.5 5.4 10 34 41 45 |
| CONFIG_SECURE | OFF ON |
| WAKE_UP | An integer between 1 and 25 |
| COMPRESS_CONFIG | OFF ON |
| INBUF | OFF ON |
| ENABLE_NDR | OFF ON |

Table 16-8. Bitstream Generation Options

| Preference Name | Values |
|--------------------------------------|---|
| Chain Mode | Disable (default) Bypass Flowthrough |
| Create bit file | True |
| No Header | True False |
| Output Format | Bit File (Binary) Mask and Readback File (ASCII) Mask and Radback File (Binary) Raw Bit file (ASCII) |
| PROM Data Output Format | Intel Hex 32-bit Motorola Hex 32-bit |
| Reset Config RAM in re-configuration | True False |
| Run DRC | True False |
| Search Path | (Enter a value or browse to specify the search path) |

Figure 16-9. Bitstream Generation Options



- Double-click the left mouse button on the **Value** you want to set. Select the desired value from the drop-down menu.
*Note: An explanation of the option is displayed at the bottom of the window. The **Help** button also invokes online help for the option.*
- Select **OK**. You can then run the Bitstream File process.

Setting Security Options in Diamond

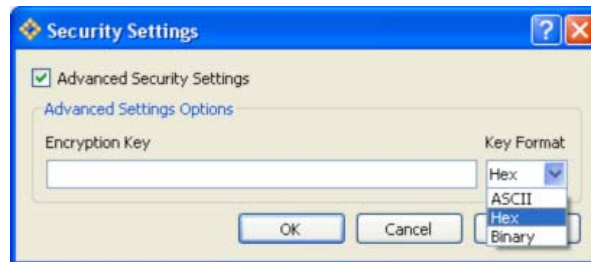
Prior to setting security options in Diamond, you must have installed the Encryption Control Pack. You must also have selected an encrypted device in your project.

To Set Security Settings, do the following:

- Select the **Tools > Security Setting** option. The following dialog box appears:



- If desired, select **Change** and enter a password.
- Select **OK**. A dialog window appears to enter an encryption key.
- If you do not want to enable an encryption key, select **OK**.
- If you do want to enable an encryption key, select the **Advanced Security Settings** checkbox, enter the **Key Format**, and then enter the **Encryption Key**.



- Select **OK** to create the encryption files.

Introduction

Soft errors occur when high-energy charged particles alter the stored charge in a memory cell in an electronic circuit. The phenomenon first became an issue in DRAM, requiring error detection and correction for large memory systems in high-reliability applications. As device geometries have continued to shrink, the probability of soft errors in SRAM has become significant for some systems. Designers are using a variety of approaches to minimize the effects of soft errors on system behavior.

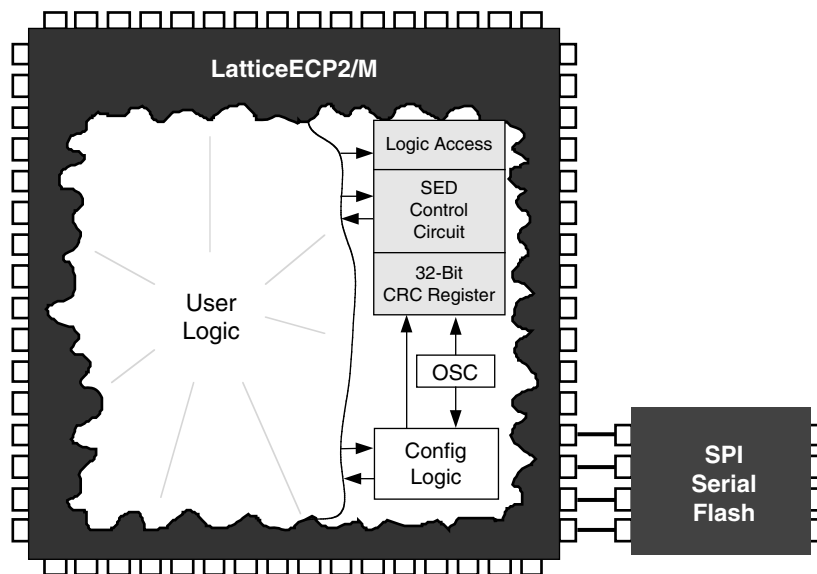
SRAM-based FPGAs store logic configuration data in SRAM cells. As the number and density of SRAM cells in an FPGA increase, the probability that a soft error will alter the programmed logical behavior of the system increases. A number of approaches have been taken to address this issue, but most involve Intellectual Property (IP) cores that the user instantiates into the logic of their design, using valuable resources and possibly affecting design performance.

This document describes the hardware based soft error detect (SED) approach taken by Lattice Semiconductor for LatticeECP2™ and LatticeECP2M™ FPGAs.

SED Overview

The SED hardware in the LatticeECP2/M devices consists of an access point to FPGA configuration memory, a controller circuit, and a 32-bit register to store the CRC for a given bitstream (see Figure 17-1). The SED hardware reads serial data from the FPGA's configuration memory and calculates a CRC. The data that is read, and the CRC that is calculated, does not include EBR memory or PFUs used as RAM. The calculated CRC is then compared with the expected CRC that was stored in the 32-bit register. If the CRC values match it indicates that there has been no configuration memory corruption, but if the values differ an error signal is generated. SED checking does not impact the performance or operation of the user logic.

Figure 17-1. System Block Diagram¹



1. Any kind of configuration memory can be used, including the SPI configuration shown.

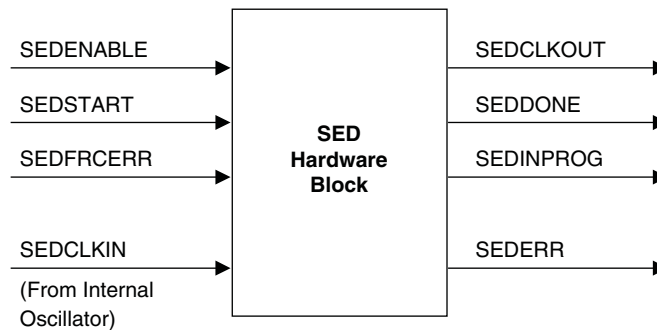
Note that the calculated CRC is based on the particular arrangement of configuration memory for a particular design. Consequently, the expected CRC results cannot be specified until after the design is placed and routed. The Lattice Diamond® bitstream generation software analyzes the configuration of a placed and routed design and updates the 32-bit SED CRC register contents during bitstream generation.

The following sections describe the LatticeECP2/M SED implementation and flow, along with some sample code to get started with.

Hardware Description

As shown in Figure 17-2, the LatticeECP2/M SED hardware has several inputs and outputs that allow the user to control, and monitor, SED behavior.

Figure 17-2. Signal Block Diagram



Signal Description

Table 17-1. SED Signal Description

| Signal Name | Direction | Active | Description |
|-------------|-----------|--------|--------------------------|
| SEDCLKIN | Input | N/A | Clock |
| SEDENABLE | Input | High | SED enable |
| SEDCLKOUT | Output | N/A | Output clock |
| SEDSTART | Input | High | Start SED cycle |
| SEDINPROG | Output | High | SED cycle is in progress |
| SEDDONE | Output | High | SED cycle is complete |
| SEDFRCERR | Input | High | Force an SED error flag |
| SEDERR | Output | High | SED error flag |

SEDCLKIN

Clock input to the SED hardware.

This clock is derived from the LatticeECP2/M on-chip oscillator. The on-chip oscillator output goes through a divider to create MCCLK. MCCLK goes through another divider to create SEDCLKIN.

The software default for MCCLK is 2.5 MHz, but this can be modified using the MCCLK_FREQ global preference in the Global Preferences tab of the Diamond Spreadsheet View (see TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#), for possible values of MCCLK).

The divider for SEDCLKIN can be set to 1, 2, 4, 8, 16 or 32. The software default is 1, so the default SEDCLKIN frequency is 2.5 MHz. The divider value can be set using a parameter, see the example code at the end of this document. Care must be taken to ensure that the SEDCLKIN setting is at least 20 MHz. Refer to Appendix A for details on MCCLK and SEDCLKIN frequencies.

Note that SEDCLKIN is an internally generated signal, so it should not be included as an input in the user design. See the examples at the end of this document. Also note that while inputs to the SED block are clocked using SEDCLKIN, no attempt has been made to synchronize between clock domains. If this is a concern for a particular design then the designer will need to provide synchronization.

SEDENABLE

Active high input to the SED hardware, sampled on the rising edge of SEDCLKIN.

Table 17-2. SEDENABLE

| State | Description |
|-------|---|
| 1 | Enables output of SEDCLKOUT, arms SED hardware. |
| 0 | Aborts SED and forces all SED hardware outputs low. |

SEDCLKOUT

Gated version of SEDCLKIN, SEDCLKOUT is gated by SEDENABLE.

SEDSTART

Active high input to the SED hardware, sampled on the rising edge of SEDCLKIN.

Table 17-3. SEDSTART

| State | Description |
|-------|---|
| 1 | Start error detection. Must be high a minimum of one SEDCLKIN period. |
| 0 | No action. |

SEDFRCERR

Active high input to the SED hardware, sampled on the rising edge of SEDCLKIN.

Table 17-4. SEDFRCERR

| State | Description |
|-------|--|
| 1 | Forces SEDERR high, simulating an SED error. |
| 0 | No action. |

SEDINPROG

Active high output from the SED hardware, clocked out on the rising edge of SEDCLKOUT.

Table 17-5. SEDINPROG

| State | Description |
|-------|--|
| 1 | SED checking is in progress, goes high on the clock following SEDSTART high. |
| 0 | SED checking is not active. |

SEDDONE

Active high output from the SED hardware, clocked out on the rising edge of SEDCLKOUT.

Table 17-6. SEDDONE

| State | Description |
|-------|--|
| 1 | SED checking is complete. Reset by a high on SEDSTART or a low on SEDENABLE. |
| 0 | SED checking is not complete. |

SEDERR

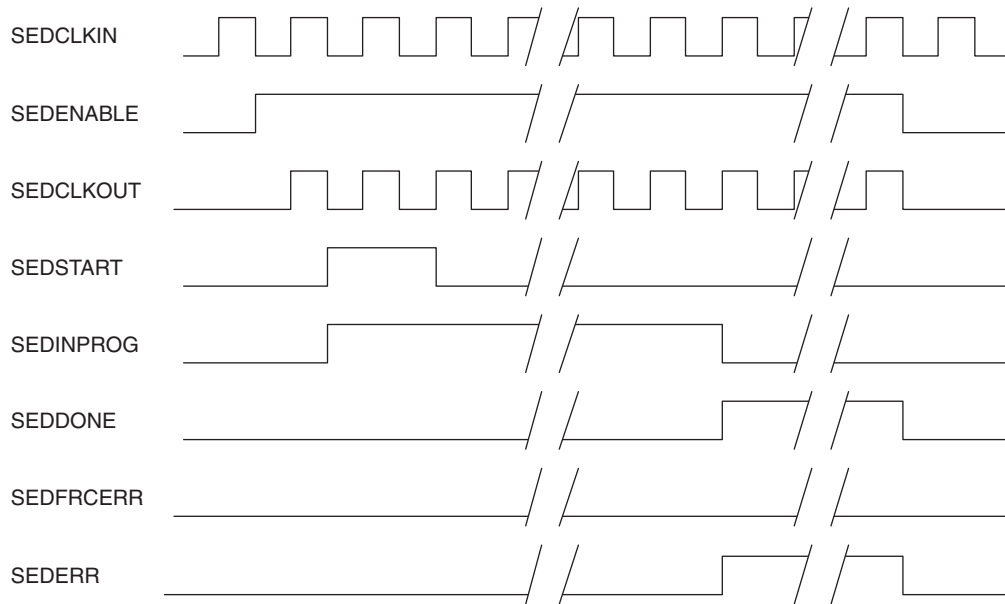
Active high output from the SED hardware, clocked out on the rising edge of SEDCLKOUT.

Table 17-7. SEDERR

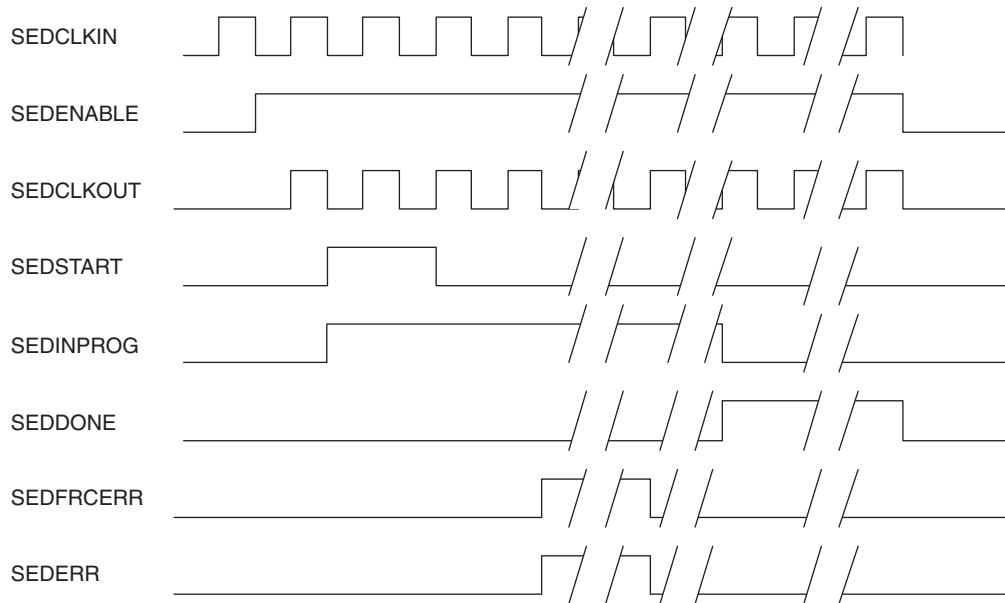
| State | Description |
|-------|--|
| 1 | SED has detected an error. Reset by SEDENABLE going low. |
| 0 | SED has not detected an error. |

SED Flow

Figure 17-3. Timing Diagram



Normal Failure



Failure Forced With SEDFRCERR

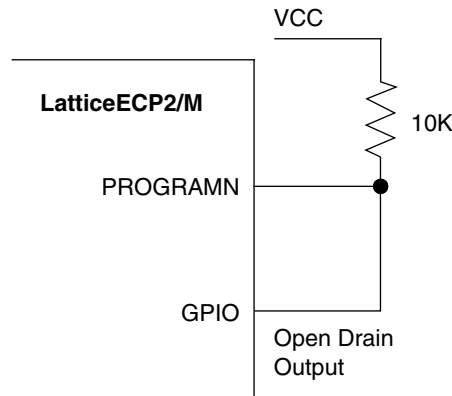
The general SED flow is as follows.

1. User logic sets SEDENABLE high. This signal may be tied high if desired.
2. User logic sets SEDSTART high. SEDINPROG goes high. If SEDDONE is already high it is driven low. SEDSTART may be tied high to enable continuous SED checking.
3. SED starts reading back data from the configuration SRAM.

4. SED finishes checking. SEDERR is updated, SEDINPROG goes low, and SEDDONE goes high.
5. If SEDERR is driven high there are only two ways to reset it, drive SEDENABLE low or reconfigure the FPGA.

The user has two choices when an error is detected, ignore the error, and possibly log it, or reconfigure the FPGA. Reconfiguration can be accomplished by driving the PROGRAMN pin low; this can be done with external logic or by wiring one of the FPGA's general purpose I/Os to the PROGRAMN pin and toggling the pin with user logic, perhaps something as simple as inverting SEDERR. If a general purpose I/O is tied to PROGRAMN it is recommended that the I/O Type be set to open drain and an external pull-up resistor be connected to the pin.

Figure 17-4. Example Schematic



SED Run Time

The amount of time needed to perform an SED check depends on the density of the device and the frequency of SEDCLKIN. There will also be some overhead time for calculation, but it is fairly short in comparison. An approximation of the time required can be found by using the following formula:

$$\text{Maxbits} / \text{SEDCLKIN} = \text{Time}$$

Maxbits is in mega-bits and depends on the density of the FPGA (see Table 17-8). SEDCLKIN is frequency in MHz. Time is in seconds

For example, if the design is using a LatticeECP2 with 50K look-up tables and the SEDCLKIN is set in the software to be 20 MHz:

$$8.9 \text{ Mbits} / 20 \text{ MHz} = 0.445 \text{ seconds}$$

In this example, SED checking will take approximately 0.445 seconds. Remember that this happens in the background and does not affect user logic performance.

Note that the internal oscillator used to generate SEDCLKIN can vary by $\pm 30\%$.

Table 17-8. SED Run Time

| Density | Bitstream Size (Mb) | Run Time ¹ (ms) |
|-----------|---------------------|----------------------------|
| ECP2-6 | 1.5 | 75 |
| ECP2-12 | 2.9 | 145 |
| ECP2-20 | 4.5 | 225 |
| ECP2-35 | 6.3 | 315 |
| ECP2-50 | 8.9 | 445 |
| ECP2-70 | 13.3 | 665 |
| ECP2M-20 | 5.9 | 295 |
| ECP2M-35 | 9.8 | 490 |
| ECP2M-50 | 15.8 | 790 |
| ECP2M-70 | 19.8 | 990 |
| ECP2M-100 | 25.6 | 1280 |

1. Based on SEDCLKIN = 20 MHz.

Sample Code

The following simple example code shows how to instantiate the SED. In the example the SED is always on and always running, and the outputs of the SED hardware have been routed to FPGA output pins.

Note that the SEDAA primitive is part of ispLEVER 6.0 or later.

VHDL Example

```

library ieee;
use ieee.std_logic_1164.all;
use ieee.std_logic_unsigned.all;

entity example is
  port (
    Sed_Done      : out std_logic;
    Sed_In_Prog   : out std_logic;
    Sed_Clk_out   : out std_logic;
    Sed_out       : out std_logic);
end;

architecture behavioral of example is

  component SEDAA -- SED component
    generic (OSC_DIV : integer := 1); -- set SEDCLKIN divider
    port (
      SEDENABLE      : in std_logic;
      SEDSTART       : in std_logic;
      SEDFRCERR      : in std_logic;
      SEDERR         : out std_logic;
      SEDDONE        : out std_logic;
      SEDINPROG      : out std_logic;
      SEDCLKOUT      : out std_logic) ;
  end component;

begin

```

```

isnt1: SEDAA
generic map (OSC_DIV=> "1")
port map (
    SEDENABLE    => '1',    -- tied high
    SEDSTART     => '1',    -- tied high
    SEDFCERR     => '0',    -- tied low
    SEDERR       => Sed_out, -- wired to an output
    SEDDONE      => Sed_Done, -- wired to an output
    SEDINPROG    => Sed_In_Prog, -- wired to an output
    SEDCLKOUT    => Sed_Clk_out ) ;    -- wired to an output

```

```
end behavioral ;
```

Verilog Example

```

module example (
    Sed_Done,
    Sed_In_Prog,
    Sed_Clk_out,
    Sed_out) ;

output Sed_Done;
output Sed_In_Prog;
output Sed_Clk_out;
output Sed_out;

assign V_hi = 1'b1;
assign V_lo = 1'b0;

SEDAA
    #(.OSC_DIV(1))

SED_IP(
    .SEDENABLE(V_hi), // always high
    .SEDSTART(V_hi), // always high
    .SEDFCERR(V_lo), // always low
    .SEDERR(Sed_out), // wired to an output
    .SEDDONE(Sed_Done), // wired to an output
    .SEDINPROG(Sed_In_Prog), // wired to an output
    .SEDCLKOUT(Sed_Clk_out)); // wired to an output

endmodule

```

Technical Support Assistance

Hotline: 1-800-LATTICE (North America)
+1-503-268-8001 (Outside North America)
e-mail: techsupport@latticesemi.com
Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|----------------|--|
| April 2006 | 01.0 | Initial release. |
| April 2006 | 01.1 | Fixed VHDL code |
| September 2006 | 01.2 | Changed FPGA family naming to show support for LatticeECP2M. |
| April 2007 | 01.3 | Updated SED Flow timing diagram. |
| September 2007 | 01.4 | Updated SEDCLKIN frequency setting. |
| February 2008 | 01.5 | Updated Timing Diagram. |
| July 2008 | 01.6 | Added note to SED Flow timing diagram. |
| January 2009 | 01.7 | Updated Verilog Example code. |
| September 2009 | 01.8 | Updated VHDL Example in the Sample Code section. |
| April 2010 | 01.9 | Changed minimum operating frequency of SEDCLKIN to be at least 20 MHz. |
| | | Updated SED Run Time table. |
| | | Corrected formula for data in SED Run Time table to use SEDCLKIN = 20 MHz. |
| January 2012 | 02.0 | Added Appendix A. |

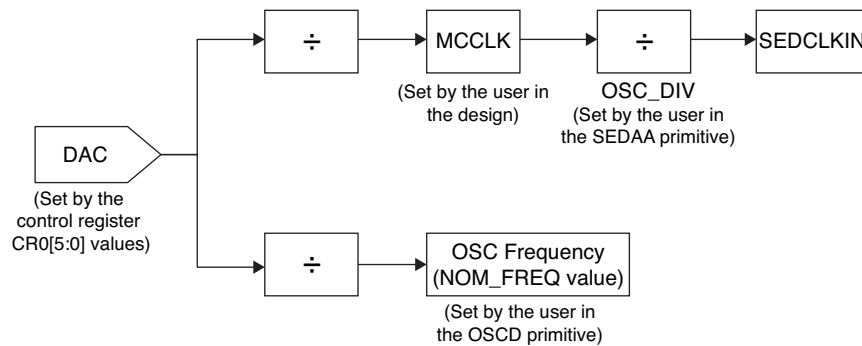
Appendix A. Calculating Exact MCCLK and SEDCLKIN Values

This appendix deals with the interdependency of the SEDCLKIN, MCCLK and the internal oscillator frequency. Figure 17-5 shows the hardware block diagram, including the internal oscillator, the MCCLK divider and the SEDCLKIN divider. The base frequency is generated by the DAC, which generates one out of four base frequencies. The internal oscillator frequency and the MCCLK and SEDCLKIN frequencies are generated by applying proper divider values to the DAC base frequency. The DAC is capable of generating only one of the four values: 260 MHz, 270 MHz, 300 MHz or 330 MHz. The selection of the base DAC frequency depends upon the internal oscillator frequency and this, in turn, affects the MCCLK and SEDCLKIN frequencies. The DAC base frequency is set by the control register CR0[5:0] values. The CR0 values can be observed in the Lattice ispVM™ System software. To see CR0 values in the ispVM tool, select **ispTools > ispVM Editors > “Control Register0 Editor..”**. The CR0[5:0] values corresponding to the DAC base frequency include:

- 011110 for 260 MHz
- 010001 for 270 MHz
- 001001 for 300 MHz
- 000001 for 330 MHz

See the ispVM Help system for more details on the ControlRegister0 Editor.

Figure 17-5. Internal Clocking Scheme



The CR0 values are selected based on the selection of valid NOM_FREQ values of the OSCD primitive for the internal oscillator. See the [LatticeECP2/M Family Data Sheet](#) for more details on the OSCD primitive.

Tables 17-9 to 17-12 show valid NOM_FREQ values and corresponding CR0[5:0] values, resulting in one of the four DAC base frequencies.

Table 17-9. NOM_FREQ Values and CR0[5:0] Values that Result in a 260 MHz DAC Base Frequency

| NOM_FREQ in OSCD Primitive (MHz) | Resulting CR0[5:0] Setting | Resulting Frequency (MHz) |
|----------------------------------|----------------------------|---------------------------|
| 2.5 | 011110 | 260 |
| 4.3 | | |
| 5.4 | | |
| 6.9 | | |
| 8.1 | | |
| 9.2 | | |
| 10 | | |
| 13 | | |
| 26 | | |

Table 17-10. NOM_FREQ Values and CR0[5:0] Values that Result in a 270 MHz DAC Base Frequency

| NOM_FREQ in OSCD Primitive (MHz) | Resulting CR0[5:0] Setting | Resulting Frequency (MHz) |
|-------------------------------------|-------------------------------|------------------------------|
| 15 | 010001 | 270 |
| 34 | | |
| 45 | | |

Table 17-11. NOM_FREQ Values and CR0[5:0] Values that Result in a 300 MHz DAC Base Frequency

| NOM_FREQ in OSCD Primitive (MHz) | Resulting CR0[5:0] Setting | Resulting Frequency (MHz) |
|-------------------------------------|-------------------------------|------------------------------|
| 30 | 001001 | 300 |

Table 17-12. NOM_FREQ Values and CR0[5:0] Values that Result in a 330 MHz DAC Base Frequency

| NOM_FREQ in OSCD Primitive (MHz) | Resulting CR0[5:0] Setting | Resulting Frequency (MHz) |
|-------------------------------------|-------------------------------|------------------------------|
| 20 | 000001 | 330 |
| 41 | | |
| 55 | | |

The default value of NOM_FREQ is 2.5 MHz, or when the OSCD primitive is not explicitly instantiated. In that case, the CR0[5:0] value is 011110, resulting in 260 MHz of DAC base frequency. If the OSCD primitive is instantiated in the design, and the NOM_FREQ value is 30 MHz, then as per Table 17-10, the tool will set the CR[5:0] value as 001001, which results in a DAC base frequency of 300 MHz.

Calculating MCCLK Frequency

The MCCLK_FREQ is 2.5 MHz by default; however, this can be set in the attributes of the SED HDL component (see sample code section or Diamond help files) and Global Constraints tab of the Diamond Spreadsheet View. Whenever the user selects a particular MCCLK frequency, the most appropriate divider value is selected, based on the DAC base frequency. As mentioned in the previous section, the DAC base frequency depends upon the OSCD NOM_FREQ value selected. Table 17-13 shows the divider values to generate the nearest MCCLK frequency, based on the DAC frequency.

Table 17-13. Divider Values to Generate Nearest MCCLK Frequency, Based on DAC Frequency

| | CR0[5:0] Setting | 011110 | 010001 | 001001 | 000001 |
|------------------|--------------------------|--------|--------|--------|--------|
| | DAC Base Frequency (MHz) | 260 | 270 | 300 | 330 |
| MCCLK_FREQ (MHz) | 2.5 | 104 | 108 | 120 | 128 |
| | 4.3 | 60 | 62 | 70 | 76 |
| | 5.4 | 48 | 50 | 56 | 62 |
| | 6.9 | 38 | 40 | 44 | 48 |
| | 8.1 | 32 | 34 | 38 | 40 |
| | 9.2 | 28 | 30 | 32 | 36 |
| | 10 | 26 | 28 | 30 | 34 |
| | 13 | 20 | 20 | 24 | 26 |
| | 15 | 18 | 18 | 20 | 22 |
| | 20 | 14 | 14 | 16 | 16 |
| | 26 | 10 | 10 | 12 | 12 |
| | 30 | 8 | 10 | 10 | 12 |
| | 34 | 8 | 8 | 8 | 10 |
| | 41 | 6 | 6 | 6 | 8 |
| | 45 | 6 | 6 | 6 | 8 |
| | 55 | 6 | 6 | 6 | 8 |
| 60 | 4 | 4 | 6 | 6 | |
| 130 | 2 | 2 | 2 | 2 | |

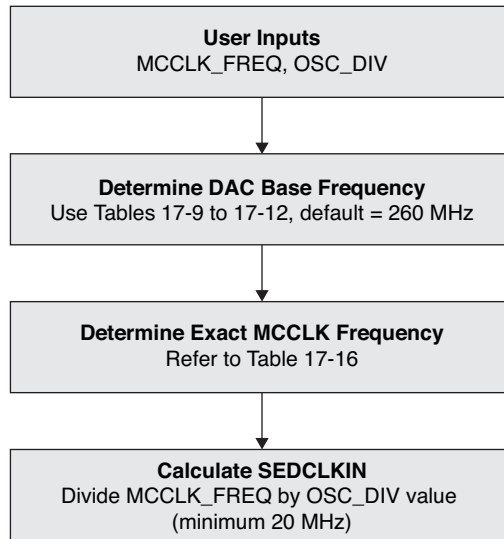
Table 17-13 shows all the valid divider values which exist in the LatticeECP2/M device. Because of these integer divider values, the exact MCCLK frequencies may not be observed in several cases. The actual MCCLK frequency is obtained by dividing the DAC base frequency by the divider value under that column, while the row corresponds to the desired MCCLK frequency.

For example, if the desired MCCLK value is 9.2 MHz, and the DAC base frequency is 300 MHz (CR0[5:0] = 001001), then the divider value would be 32. Thus, the MCCLK value would be $300/32 = 9.375$. Similarly, with a DAC base frequency of 260 MHz, if MCCLK_FREQ is 41, 45 or 55, the same divider value is selected, resulting in the same output frequency.

Calculating the SEDCLKIN

Once the MCCLK frequency has been calculated, the SEDCLKIN is calculated by dividing the MCCLK by a valid set of divider values, as defined by OSC_DIV parameter of the SEDAA primitive. In effect, $SEDCLKIN = MCCLK/OSC_DIV$. Due to the discrete nature of divider values and four different DAC Base frequencies, the exact SEDCLKIN cannot be expected. The variation can go up to $\pm 30\%$ as mentioned in the DC and Switching Characteristics section of the [LatticeECP2/M Family Data Sheet](#). Figure 17-6 shows the steps required to calculate the SEDCLKIN frequency.

Figure 17-6. Calculating SEDCLKIN Frequency



Introduction

When designing complex hardware using the LatticeECP2/M FPGA, designers must pay special attention to critical hardware configuration requirements. This technical note steps through these critical hardware implementation items relative to the LatticeECP2/M device. The device family consists of FPGA LUT densities ranging from 6K to 100K. This technical note assumes that the reader is familiar with the LatticeECP2/M device features as described in the [LatticeECP2/M Family Data Sheet](#).

The critical hardware areas covered in this technical note are:

- Power supplies as they relate to the LatticeECP2/M supply rails and how to connect them to the PCB and the associated system
- Configuration mode selection for proper power-up behavior
- Device I/O interface and critical signals

Power Supplies

The V_{CC} , V_{CCIO8} and V_{CCAUX} power supplies determine the LatticeECP2/M internal “power good” condition. In addition to the three power supplies, there are $V_{CCIO0-7}$, V_{CCPLL} and V_{CCJ} supplies that power the I/O banks, PLL and JTAG port. All power supplies are required for proper device operation but since V_{CC} , V_{CCIO8} and V_{CCAUX} determine the device power-on condition, it is recommended that one of these supplies should be the final power supply to power up the LatticeECP2/M device after all other power supplies are stable. Table 18-1 shows the power supplies and the appropriate voltage levels for each supply.

Table 18-1. Power Supply Description and Voltage Levels

| Supply | Voltage (Typical) | Description |
|---------------|-------------------|---|
| V_{CC} | 1.2V | Core power supply. A nominal trip point for V_{CC} power supply is 1.0V. |
| V_{CCAUX} | 3.3V | Auxiliary power supply. A 3.3V supply that provides an internal reference to the input buffers. A nominal trip point for V_{CCAUX} is 2.9V. |
| V_{CCPLL} | 1.2V | Power supply for PLL. Available on larger devices only. |
| $V_{CCIO0-7}$ | 1.2V to 3.3V | I/O power supply. There are eight general purpose I/O banks and each bank has its own supply $V_{CCIO0} - V_{CCIO7}$. |
| V_{CCIO8} | 1.2V to 3.3V | Configuration I/O bank power supply. A nominal trip point for V_{CCIO8} is 1.0V. |
| V_{CCJ} | 1.2V to 3.3V | JTAG power supply for the TAP controller port. |

LatticeECP2M SERDES/PCS Power Supplies

When using the SERDES with 1.5V VCCIB or VCCOB, the SERDES should not be left in a steady state condition with the 1.5V power applied and the 1.2V power not applied. Both the 1.2V and the 1.5V power should be applied to the SERDES at nominally the same time. The normal variation in ramp_up times of power supplies and voltage regulators is not a concern.

All VCCTX, VCCR, VCCP and VCCAUX33 supply pins must always be powered to the recommended operating voltage range regardless of the SERDES use. When SERDES channels are not used, the required supplies can be connected to the standard FPGA 1.2V or 3.3V power supplies since the noise levels of these supplies are not critical. VCCIB and VCCOB could be left floating for unused SERDES channels. Unused channel outputs are tristated, with approximately 10 KOhm internal resistor connecting between the differential output pair.

VCCAUX33 supplies power to termination resistors. As a result, noise on VCCAUX33 is directly coupled with the high-speed I/O, HDIN/HDOUT. A clean FPGA core VCCAUX (power supply) can be used to supply the SERDES VCCAUX33. Unused SERDES channels are configured in power-down mode by default.

Table 18-2 shows the power supplies and the appropriate voltage levels for each supply.

Table 18-2. Power Supply Description and Voltage Levels

| Supply | Voltage (Typical) | Description |
|------------------------------|-------------------|---|
| V _{CCTX} | 1.2V | Transmit power supply |
| V _{CCR_X} | 1.2V | Receive power supply |
| V _{CCP} | 1.2V | PLL and reference clock buffer power |
| V _{CCIB} | 1.2V/1.5V | Input buffer power supply |
| V _{CCOB} | 1.2V/1.5V | Output buffer power supply |
| V _{CCAUX33} | 3.3V | Termination resistor switching power supply |

Power Supply Sequencing

There are three main power supplies that are required to power-up the LatticeECP2/M device for proper operation: V_{CC}, V_{CCAUX} and V_{CCIO8}. There is no specific power sequencing requirement for the LatticeECP2/M device family. If the user's system has the option to design for power sequencing, a practical sequencing is V_{CC} before V_{CCAUX} or V_{CCIO8}. V_{CC} should reach its minimum voltage value before V_{CCAUX} and V_{CCIO8} reach their minimum values. For the LatticeECP2/M "S" version only, V_{CC} must reach its valid minimum value before powering up V_{CCAUX}. Power sequencing considerations should also consider that common supplies are generally tied together to the same rail. For example, if there is a 3.3V V_{CCIO}, it should be tied to the same supply as the 3.3V rail for V_{CCAUX}, thus minimizing leakage.

Power Supply Ramp

For the LatticeECP2/M, it is important to make sure that the power supply ramp times stay within a reasonable range. Each power supply must follow a monotonically clean ramp between the trip points and the minimum required supply voltage. Slow power supply ramps in the tens of milliseconds to hundreds of milliseconds are critical to ensure that the transitions around trip points are monotonic.

Multiple transitions through the trip point may cause multiple internal power-on reset sequencing.

Power Estimation

Once the LatticeECP2/M device density, package and logic implementation is decided, power estimation for the system environment should be determined based on the software Power Calculator provided as part of the isp-LEVER[®] design tool. When estimating power, the designer should keep two goals in mind:

1. Power supply budgeting should be based on the maximum of the power-up in-rush current, configuration current or maximum DC and AC current for the given system's environmental conditions.
2. The ability for the system environment and LatticeECP2/M device packaging to be able to support the specified maximum operating junction temperature.

By determining these two criteria, LatticeECP2/M power requirements are taken into consideration early in the design phase.

Configuration

All LatticeECP2/M devices contain two ports that can be used for device configuration. The Test Access Port (TAP), which supports bit-wide configuration, and the sysCONFIG[™] port, which supports both byte-wide and serial configuration.

Table 18-3 shows the associated CFG pin definitions.

Table 18-3. Configuration Mode Selection

| Configuration Mode | CFG[2] | CFG[1] | CFG[0] | D[0]/SPIFASTN |
|---------------------------------|--------|--------|--------|---------------|
| SPI (Normal, 0x03) | 0 | 0 | 0 | Pull-Up |
| SPI (Fast, 0x0B) | 0 | 0 | 0 | Pull-Down |
| SPI _m (Normal, 0x03) | 0 | 1 | 0 | Pull-Up |
| SPI _m (Fast, 0x0B) | 0 | 1 | 0 | Pull-Down |
| Slave Serial | 1 | 0 | 1 | X |
| Slave Parallel | 1 | 1 | 1 | D0 |

The configuration port resides in I/O bank 8 and has dedicated/shared I/Os for configuration. Shared pins are available as a user I/O after configuration, if PERSISTENT is OFF.

V_{CCIO8} must match the supply voltage of the SPI Flash. For example, if the external SPI Flash operates at 3.3V, V_{CCIO8} must be tied to the 3.3V supply rail as well.

Table 18-4 lists the sysCONFIG pins. If any of these pins are used for configuration or user I/O, the designer must adhere to the requirements listed in TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#).

Table 18-4. Configuration Pin Descriptions

| Pin Name | I/O Type | Pin Type | Description |
|---------------|---|--------------|---|
| CFG[2:0] | Input, weak pull-up | Dedicated | FPGA configuration mode selection |
| PROGRAMN | Input, weak pull-up | Dedicated | FPGA Configuration control and status signals |
| INITN | Bi-Directional Open Drain, weak pull-up | Dedicated | |
| DONE | Bi-Directional Open Drain with weak pull-up or Active Drive | Dedicated | |
| CCLK | Input or Output | Dedicated | Configuration clock |
| DI/CSSPI0N | Input, weak pull up | Dual-purpose | SPI control and data signals |
| DO/CSN | Output | Dual-purpose | |
| CSN | Input, weak pull up | Dual-purpose | |
| CS1N | Input, weak pull up | Dual-purpose | |
| WRITEN | Input, weak pull up | Dual-purpose | |
| BUSY/SISPI | Output, tri-state, weak pull-up | Dual-purpose | |
| D[0]/SPIFASTN | Input or Output, weak pull-up | Dual-purpose | |
| D[1:6] | | | |
| D[7]/SPID0 | | | |
| TDI | Input, weak pull-up | Dedicated | |
| TDO | Output, weak pull-up | | |
| TCK | Input with Hysteresis | | |
| TMS | Input, weak pull-up | | |

JTAG Interface

The JTAG interface pins are referenced to V_{CCJ} . Typically, JTAG pins are referenced to a 3.3V supply. V_{CCJ} can support supplies from 1.2V to 3.3V. In cases where V_{CCJ} is connected to supplies other than 3.3V, validate that the JTAG interface cable or tester can support an I/O interface with the same I/O voltage standard.

I/O Interface and Critical Pins

There are nine I/O banks on every LatticeECP2/M device. V_{CCIO8} is the configuration I/O bank and as such, the configuration requirements should have the highest priority to determine the supply voltage levels.

I/O Pin Assignments Around V_{CCPLL}

The V_{CCPLL} provides a “quiet” supply for the internal PLLs. For the best PLL jitter performance, careful pin assignment will keep “noisy” I/O pins away from “sensitive” pins, as shown in the BGA ball locations identified in Figure 18-1. In this case, the sensitive pin is one of the V_{CCPLL} supply pins. The noisy I/O pins generally have the highest switching frequency, the highest V_{CCIO} standard and the fastest output slew rates. For example, using Figure 18-1, one can identify the “keep out” ball locations for potentially noisy signals.

Figure 18-1. “Quiet” Pin Assignment Considerations for BGA Packages

| | | | | |
|-----|-----|---------------|-----|-----|
| 5x5 | 5x5 | 5x5 | 5x5 | 5x5 |
| 5x5 | 3x3 | 3x3 | 3x3 | 5x5 |
| 5x5 | 3x3 | Sensitive Pin | 3x3 | 5x5 |
| 5x5 | 3x3 | 3x3 | 3x3 | 5x5 |
| 5x5 | 5x5 | 5x5 | 5x5 | 5x5 |

PLLCAP

An optional external capacitor can be used with both EXHPLL and EPLL to change the frequency response of the on-chip loop filter. When an external capacitor is used, it allows the PLLs to extend the low-end of their operating ranges. IPexpress™ checks the phase detector frequency to determine if an external capacitor is required. The allowable ranges for the PLL parameters with and without the external capacitor are described in the [LatticeECP2/M Family Data Sheet](#).

Recommended optional external capacitor specifications:

- **Value:** 5.6 nF, +/- 20%
- **Type:** Ceramic chip capacitor, NPO dielectric
- **Package:** 1206 or smaller

Each device has two external capacitor pins, one for the left-side PLLs and one for the right-side PLLs. These pins are in fixed locations. They are dedicated function pins that are NOT shared with user I/Os. When an external capacitor pin is used by a PLL on one side of the device, it cannot be used by any other PLLs on the same side of the device. This means that a maximum of two PLLs per device, one on the left side and one on the right side, can have external capacitors attached.

Placing the capacitors at the PLLCAP pins only affects the PLL response when the software enables this feature. This allows a designer to provide the capacitors (or unpopulated PCB pads) to the PLLCAP pins to utilize the lower PLL frequencies if it becomes necessary for future changes to the design.

DDR/DDR2 Memory Interface Pin Assignments

The DDR Memory interface on the LatticeECP2/M device family is provided with a pre-engineered I/O register along with the precision I/O DLL timing control. There are two I/O DLLs specifically assigned to the two halves of the device. One I/O DLL supports I/O banks 2, 3 and 4; another I/O DLL supports I/O banks 5, 6 and 7.

In addition to the I/O DLL assignments, there are pre-defined data strobe (DQS) signals that can support a span of I/O pins as part of the memory data lanes. When assigning DDR memory interface I/O pins, the FPGA designer must insure that there are enough I/O pins to assign DDR memory data pins for each of the assigned DQS signals.

When interfacing to the DDR memory, the I/O type used is SSTL18 for DDR2 memory or SSTL25 for the DDR1 memory interface. The VREF required for these SSTL buffers should be assigned to VREF1 of the bank.

True-LVDS Output Pin Assignments

True-LVDS outputs are available on 50% of the I/O pins on the left and right sides of the device. The left- and right-side I/O banks are banks 2, 3, 6 and 7. When using the LVDS outputs, a 2.5V supply must be connected to these V_{CCIO} supply rails.

HSTL and SSTL Pin Assignments

These externally referenced I/O standards require an external reference voltage. Each of the LatticeECP2/M device family I/O banks allow up to two pre-defined V_{REF} pins. The V_{REF} pin(s) should get the highest priority when assigning pins.

PCI Clamp Pin Assignments

In LatticeECP2 devices, only the I/Os on the bottom banks have programmable PCI clamps. In LatticeECP2M devices, the I/Os on the left and bottom banks have the programmable PCI clamps. When the system design calls for a PCI clamp, those pins should be assigned to I/O banks 4 and 5 for LatticeECP2 and banks 4, 5, 6 and 7 for LatticeECP2M. For clamp characteristics, refer to the IBIS buffer models either on the Lattice website or ispLEVER design tool.

Checklist

| | LatticeECP2/M Hardware Checklist Items | OK | N/A |
|-------|--|----|-----|
| 1 | Power Supply | | |
| 1.1 | Core Supply VCC @1.2V | | |
| 1.2 | Auxiliary Supply VCCAUX @3.3V | | |
| 1.3 | PLL Supply VCCPLL @1.2V | | |
| 1.4 | JTAG Supply VCCJ from 1.2V-3.3V | | |
| 1.5 | I/O Supply VCCIO0-8 from 1.2V-3.3V | | |
| 1.6 | 10K +/-1% Pull down on XRES | | |
| 1.6 | Supply Sequencing considerations | | |
| 1.7 | Supply Ramp considerations | | |
| 1.8 | Power Estimation | | |
| 1.9 | Capacitor on PLLCAP pins (optional if using lower PLL frequencies) | | |
| 2 | Configuration | | |
| 2.1 | Consistency of VCCIO8 Supply when external SPI Flash is used | | |
| 2.2 | Configuration control and status selections | | |
| 2.2.1 | Pull-up or Pull-down on CFG2, CFG1, CFG0 | | |
| 2.2.4 | Pull-up on PROGRAMN, INITN, DONE | | |
| 2.2.5 | Pull-up or pull-down on SPIFASTN (SPI mode) | | |
| 2.2.5 | Pull-down on TCK | | |
| 2.2 | JTAG Supply and default logic levels | | |

Checklist (Continued)

| | LatticeECP2/M Hardware Checklist Items | OK | N/A |
|-----|--|----|-----|
| 3 | I/O Pin Assignments | | |
| 3.1 | I/O pin assignments around VCCPLL | | |
| 3.2 | DDR Memory pin assignment considerations | | |
| 3.3 | True-LVDS pin assignment considerations | | |
| 3.4 | HSTL and SSTL pin assignment considerations | | |
| 3.5 | PCI clamp requirement considerations | | |
| 4 | LatticeECP2M SERDES | | |
| 4.1 | Transmitter power supply VCCTX@1.2V | | |
| 4.2 | Receiver power supply VCCR@1.2V | | |
| 4.3 | TXPLL & reference clock buffer power VCCP@1.2V | | |
| 4.4 | VCCIB & VCCOB (floating if Serdes are not used)@1.2V/1..5V | | |
| 4.5 | Termination resistor switching power supply VCCAUX33@3.3V | | |

Technical Support Assistance

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 +1-503-268-8001 (Outside North America)

e-mail: techsupport@latticesemi.com

Internet: www.latticesemi.com

Revision History

| Date | Version | Change Summary |
|----------------|---------|---|
| July 2007 | 01.0 | Initial release. |
| September 2007 | 01.1 | Updated Power Supply Sequencing text section. |

Introduction

The LatticeECP3™ and LatticeECP2M™ families are low-cost FPGA product lines offering high-end features such as high-speed, embedded SERDES (SERializer/DESerializer) interfaces. These devices feature up to 16 SERDES channels with data rates of up to 3.125 Gbps.

This technical note outlines two experiments that measure the SERDES backplane transmission performance thresholds of the LatticeECP3 and LatticeECP2M devices. These experiments include:

- **Eye Diagram Experiment:** Uses eye diagrams to explore FPGA performance over a standard reference backplane.
- **Data Rate Experiment:** Uses bit error rate measurement techniques to verify FPGA backplane data rate limits at varying speeds and trace lengths.

Both experiments use a bit error rate tester (BERT) for pattern generation, a Tyco HM-Zd as the backplane and a LatticeECP3 or LatticeECP2M FPGA as the device under test. Both experiments collect data at 2.5 Gbps and 3.125 Gbps and use pre-emphasis adjustments to optimize transmitter performance.

Eye Diagram Experiment

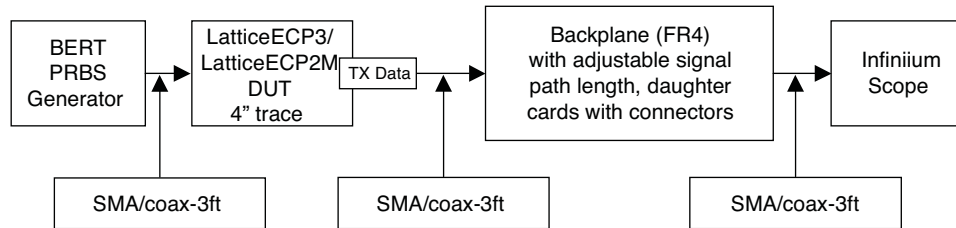
The eye diagram experiment checks the ability of the LatticeECP3 or LatticeECP2M FPGA to drive SERDES signals through a backplane at different pre-emphasis levels and data rates. It provides a visual, qualitative measurement of link performance by persistently sampling the signal at the receive end of the backplane.

In this configuration, a pseudo-random bit sequence (PRBS) pattern is generated and then sent into the LatticeECP3 or LatticeECP2M DUT. The PRBS is looped back and transmitted by the DUT into the backplane. The signal is routed out of the backplane, where it is sampled on an oscilloscope and eye diagrams are assembled. This experiment was performed at 2.5 Gbps and 3.125 Gbps with different levels of pre-emphasis. See Figure 19-1 for an illustration.

The equipment used in this test includes:

- Tyco HM-Zd Quad Route Test backplane with two daughter cards
- Agilent Infiniium DSO81304B 13 GHz oscilloscope
- High-quality coaxial cabling (rated for >3.125 Gbps) with SMA connectors
- Agilent 81250 3.7 GHz Parallel Bit Error Tester (ParBERT)
- Agilent 81130A function/pulse generator
- Agilent E3610A power supply
- Thermonics Thermostream for temperature control
- Internal LatticeECP3 and LatticeECP2M evaluation boards

Figure 19-1. Eye Diagram Experiment Setup



Backplane Specifications

- Tyco Electronics HM-Zd Quad Route Test backplane with daughter cards
- Backplane – 200 mils thick with 14 layers, made from Nalco 4000-FR4 material
- Signal layers 10 mil wide (1/2 copper thickness) designed for 100-ohm differential impedance traces
- Daughter cards – 93 mil thick with 14 layers
- Daughter cards – 6 mil wide, 100-ohm differential impedance traces
- Backplane trace length 40 inches

Test Setup Parameters

- DUT (LatticeECP3 or LatticeECP2M fpBGA)
- SERDES VCC supply values: 1.2V -5%
- Ambient temperature: 125°C
- Data pattern = PRBS (7-bit polynomial)
- Socketed, nominal device

Eye Diagram Measurements

Receiver end eye diagrams are an excellent measurement of expected link performance. This experiment tested a 40-inch length trace path, whereas most applications will have a 12 to 24 inch path. Eye diagrams were taken at 2.5 Gbps and 3.125 Gbps at varied pre-emphasis levels.

Pre-emphasis compensates for signal losses that occur with higher speeds and longer trace lengths. In general, increasing pre-emphasis will increase the signal quality for an improved eye diagram. The FPGA provides eight programmable pre-emphasis levels, available on a per-channel basis. To illustrate the progressive advantages of increased pre-emphasis, Tables 19-1 and 19-2 show eye diagrams taken at six of these pre-emphasis settings, each sampled at both 2.5 Gbps and 3.125 Gbps. Eye opening widths (measured in pS) and peak-to-peak voltage swings (in mV) are listed with each sample. For each of these measurements, larger is better.

Table 19-1. LatticeECP3 Eye Diagram Measurements

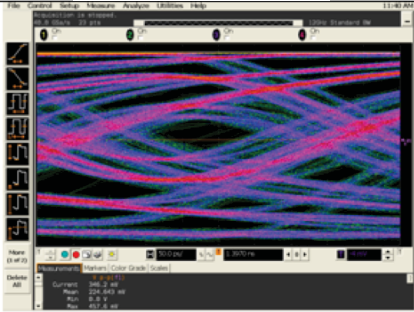
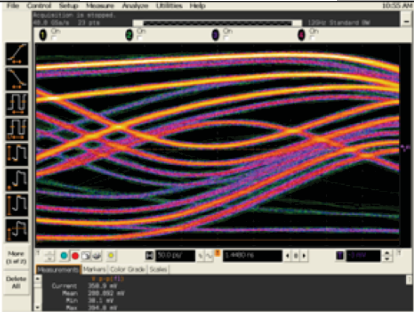
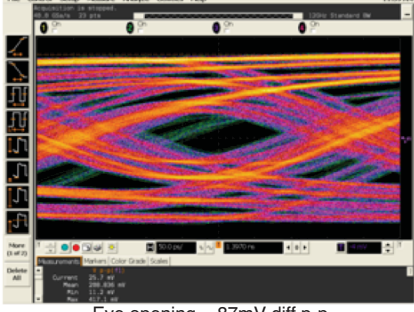
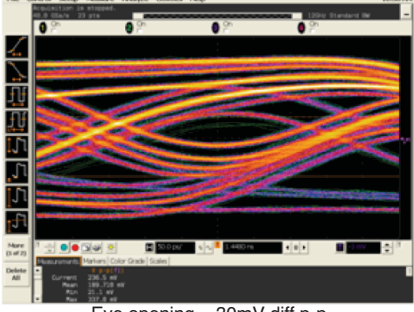
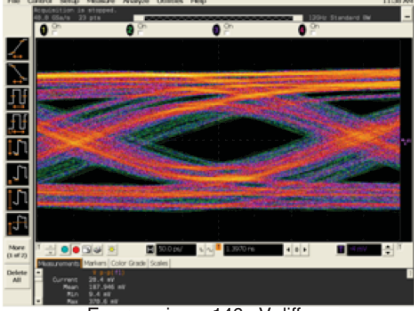
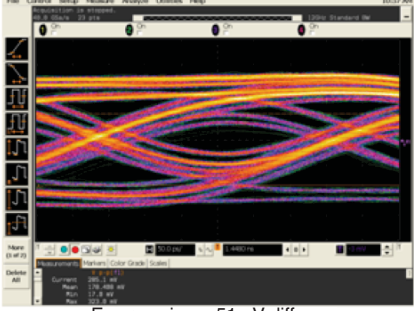
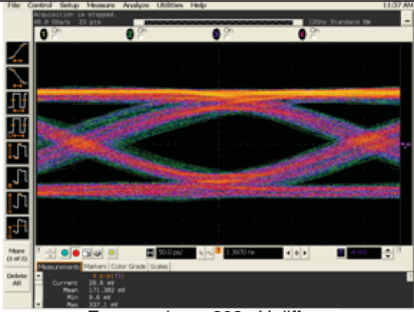
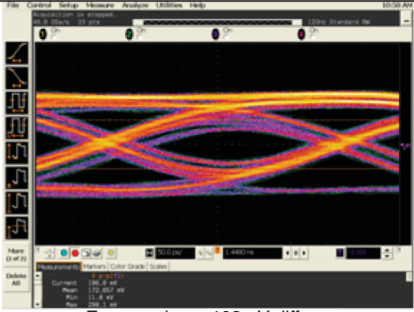
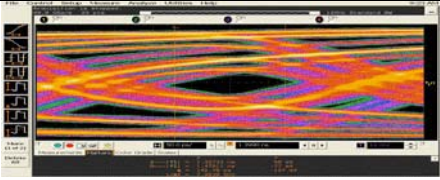

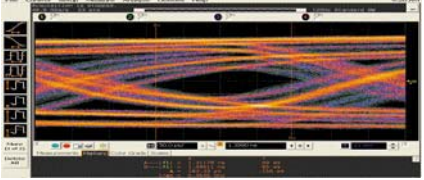
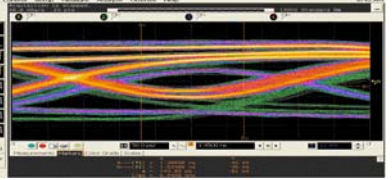
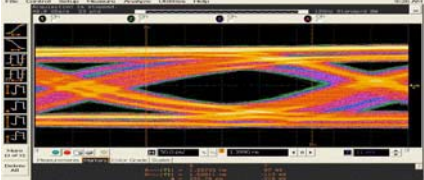
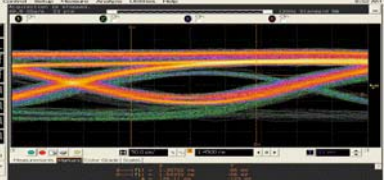
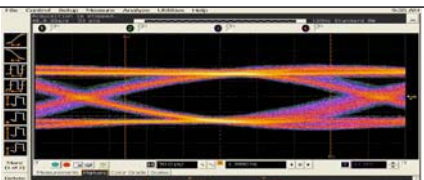
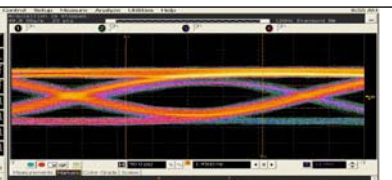
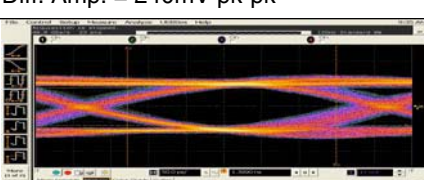
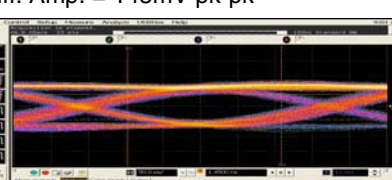
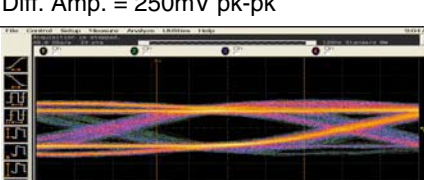
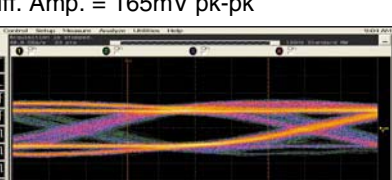
| Pre-emphasis | 2.5 Gbps | 3.125 Gbps |
|------------------------|---|---|
| <p>Disabled 0%</p> |  <p>No detectable eye</p> |  <p>No detectable eye</p> |
| <p>1 (5%)</p> |  <p>Eye opening = 87mV diff p-p</p> |  <p>Eye opening = 30mV diff p-p</p> |
| <p>2 (12%)</p> |  <p>Eye opening = 146mV diff p-p</p> |  <p>Eye opening = 51mV diff p-p</p> |
| <p>3 (18%)</p> |  <p>Eye opening = 203mV diff p-p</p> |  <p>Eye opening = 103mV diff p-p</p> |

Table 19-2. LatticeECP2M Eye Diagram Measurements

| Pre-Emphasis Setting | 2.5 Gbps | 3.125 Gbps |
|-----------------------|---|--|
| Pre-Emphasis Disabled |  <p>Eye opening= 140pS, Diff. Amp. = 130mV pk-pk</p> |  <p>Eye opening= 110pS, Diff. Amp. = 45mV pk-pk</p> |
| 1 (16%) |  <p>Eye opening= 180pS, Diff. Amp. = 155mV pk-pk</p> |  <p>Eye opening= 140pS, Diff. Amp. = 80mV pk-pk</p> |
| 2 (36%) |  <p>Eye opening= 220pS, Diff. Amp. = 210mV pk-pk</p> |  <p>Eye opening= 176pS, Diff. Amp. = 123mV pk-pk</p> |
| 4 (44%) |  <p>Eye opening= 265pS, Diff. Amp. = 240mV pk-pk</p> |  <p>Eye opening= 194pS, Diff. Amp. = 145mV pk-pk</p> |
| 5 (56%) |  <p>Eye opening= 270pS, Diff. Amp. = 250mV pk-pk</p> |  <p>Eye opening= 210pS, Diff. Amp. = 165mV pk-pk</p> |
| 6 (80%) |  <p>Eye opening= 270pS, Diff. Amp. = 210mV pk-pk</p> |  <p>Eye opening= 195pS, Diff. Amp. = 160mV pk-pk</p> |

Results and Conclusion

Tables 19-1 and 19-2 show that for both data rates the eye opening width and the pk-pk height were maximized at a pre-emphasis of 5. However, if the receiver sensitivity requirements are met, the user might choose a lower pre-emphasis setting in the interest of power savings and lower EM radiation. For example, the LatticeECP3 and LatticeECP2M SERDES receive ports have a minimum input differential sensitivity of 100 mV, so even with pre-emphasis disabled, this requirement would be met at 2.5 Gps (130 mV pk-pk).

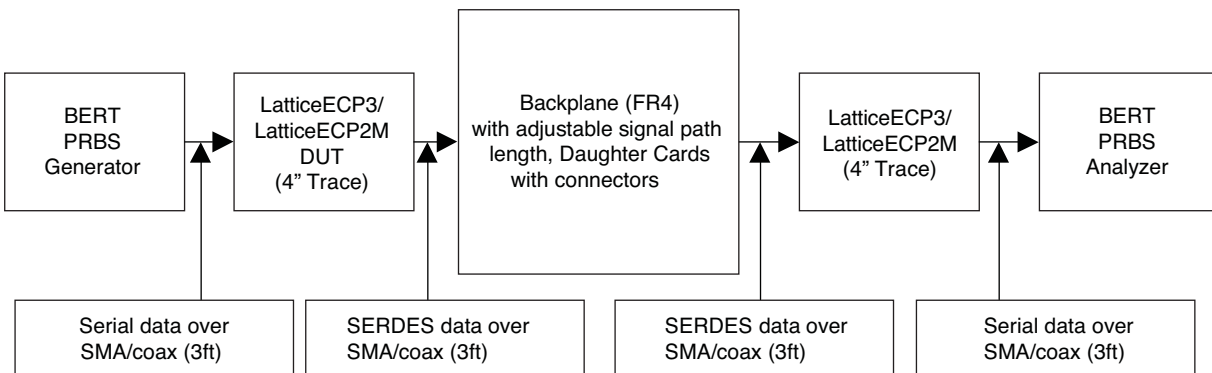
The eye diagrams in this experiment demonstrate that the LatticeECP3 and LatticeECP2M effectively provide high-quality signaling in a long trace, backplane design. These diagrams also show that pre-emphasis settings can be used to optimize SERDES performance.

Data Rate Experiment

The data rate experiment checks the FPGA SERDES transmission performance using a Bit Error Rate Tester (BERT) for expected/received data comparisons in a pass/fail context. The configuration begins by generating a PRBS sequence at a BERT, then sending the pattern into a LatticeECP3 or LatticeECP2M DUT. The FPGA loops the data back to the backplane as a SERDES bitstream. The SERDES data then exits the backplane and is received by the LatticeECP3 or LatticeECP2M (not necessarily the same device as the earlier DUT), which loops the data back to a BERT analyzer. Finally, the BERT compares the incoming bitstream to an expected data pattern and keeps track of how many mismatches are found. A typical expected bit error rate (BER) is less than 1×10^{-12} errors per second. See Figure 19-2 for an illustration.

The equipment used for this test was the same as used for the eye diagram experiment.

Figure 19-2. Data Rate Experiment



Backplane Specifications

- Backplane specifications are the same as for the eye diagram experiment
- Total trace length: 60 inches for 2.5 Gbps testing and 40 inches for 3.125 Gbps testing

Test Setup Parameters

- DUT (LatticeECP3 or LatticeECP2M fpBGA)
- Ambient temperature: 125°C
- SERDES VCC supply values: 1.2V -5%
- Socketed device
- All process variations
- Pre-emphasis setting: 4
- Equalization: 8 db

Data Rate Measurements

The data rate experiment was performed against samples from five process variations. Each sample was tested at 2.5 Gbps and 3.125 Gbps. The pass criterion was BER of less than 1×10^{-12} errors per second.

Results and Conclusions

For all process splits, the FPGA samples achieved a BER of better than 1×10^{-12} at 3.125 Gbps and 2.5 Gbps. This indicates that with a pre-emphasis setting of 4, the LatticeECP3 and LatticeECP2M can drive SERDES data error-free up to 40 inches of backplane at 3.125 Gbps and 40 inches of backplane with margin at 2.5 Gbps.

Conclusions and Design Guidelines

The experiments detailed in this technical note measured the ability of the LatticeECP3 and LatticeECP2M to reliably transmit SERDES data streams in a typical backplane design. The data-rate experiment used a statistical pass/fail scenario, whereas the eye-diagram experiment provided a visual, qualitative measurement. Both experiments concluded that the LatticeECP3 and LatticeECP2M deliver high-quality SERDES transmission over long backplane distances and over a broad range of data rates.

In both experiments, pre-emphasis was used to optimize LatticeECP3 and LatticeECP2M backplane performance. The eye diagram experiment went further to demonstrate that increased pre-emphasis provides a larger eye opening. Pre-emphasis settings are available on a per-channel basis.

Both experiments proved LatticeECP3 and LatticeECP2M performance at 2.5 Gbps and 3.125 Gbps. The data-rate experiment went further to show that devices from all process variations meet these performance goals.

Due to the number of factors in a high-speed PCB design, it is difficult to predict system performance in all scenarios. The data rate experiment illustrated robust performance at 3.125 Gbps over 40 inches in typical conditions, even for the slowest speed grades of the devices. The maximum trace length that can be implemented for an individual system environment may vary and should be evaluated by the individual designer.

The following suggestions will help designers optimize their high-speed LatticeECP3 and LatticeECP2M applications:

1. It is critical that all SERDES path cables and connectors be carefully selected. Cabling should be high-quality coaxial and connectors should be SMA. Both should be characterized for the intended frequency range. The designer should pay close attention to the parasitic performance of these devices.
2. Backplane and port cards should be implemented with good high-speed design practices in mind. For more details see TN1033, [High-Speed PCB Design Considerations](#).
3. To improve the performance of receivers, use the LatticeECP3 or LatticeECP2M programmable equalization settings. For example, 8 db was used in the data rate experiment in this technical note.
4. Use analog circuit simulation tools to assess backplane performance signal integrity issues prior to building models. Contact Lattice for information about obtaining LatticeECP3 or LatticeECP2M SERDES HSPICE models for your simulations.
5. Early lab experimentation of long paths are recommended prior to full system model design in order to reduce technical risk. Eye diagram and bit error rate experiments are recommended.

References

- TN1118, [LatticeSC High-Speed Backplane Measurements](#)
- TN1176, [LatticeECP3 SERDES/PCS Usage Guide](#)
- TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#)
- TN1033, [High-Speed PCB Design Considerations](#)
- TN1114, [Electrical Recommendations for Lattice SERDES](#)

Technical Support Assistance

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Revision History

| Date | Version | Change Summary |
|---------------|---------|--|
| February 2007 | 01.0 | Initial release. |
| March 2007 | 01.1 | Updated LatticeECP2M Eye-Diagram Measurements table. |
| April 2007 | 01.2 | Updated Eye-Diagram Measurements section. |
| May 2010 | 01.3 | Added LatticeECP3 FPGA data. |



Section III. LatticeECP2/M Family Handbook Revision History

Revision History

| Date | Handbook Revision Number | Change Summary |
|------------------------------|--------------------------|--|
| February 2006 | 01.0 | Initial release. |
| August 2006 | 01.1 | LatticeECP2 Family Data Sheet updated to version 01.1. |
| | | Technical note TN1103 updated to version 01.1. |
| | | Technical note TN1104 updated to version 01.1. |
| September 2006 | 02.0 | Technical note TN1108 updated to version 01.2. |
| | | LatticeECP2 Family Data Sheet updated to version 02.0. |
| | | Technical note TN1102 updated to version 02.0. |
| | | Technical note TN1103 updated to version 01.2. |
| | | Technical note TN1104 updated to version 01.2. |
| | | Technical note TN1105 updated to version 02.0. |
| | | Technical note TN1106 updated to version 01.1. |
| | | Technical note TN1107 updated to version 01.1. |
| | | Technical note TN1108 updated to version 01.3. |
| | | Added technical note TN1109. |
| | | Added technical note TN1113. |
| Added technical note TN1124. | | |
| December 2006 | 02.1 | LatticeECP2/M Family Data Sheet updated to version 02.2. |
| | | Technical note TN1106 updated to version 01.2. |
| | | Technical note TN1103 updated to version 01.3. |
| February 2007 | 02.2 | Technical note TN1103 updated to version 01.4. |
| | | Technical note TN1106 updated to version 01.3. |
| | | Added technical note TN1149. |
| February 2007 | 02.3 | LatticeECP2/M Family Data Sheet updated to version 02.3. |
| March 2007 | 02.4 | LatticeECP2/M Family Data Sheet updated to version 02.4. |
| | | Technical note TN1105 updated to version 01.3. |
| | | Technical note TN1108 updated to version 01.4. |
| March 2007 | 02.5 | Technical note TN1124 updated to version 02.0. |
| | | Technical note TN1149 updated to version 01.1. |
| March 2007 | 02.6 | LatticeECP2/M Family Data Sheet updated to version 02.5. |
| | | Technical note TN1108 updated to version 01.5. |
| | | Technical note TN1109 updated to version 01.2. |
| March 2007 | 02.7 | Technical note TN1124 updated to version 02.0. |
| April 2007 | 02.8 | LatticeECP2/M Family Data Sheet updated to version 02.6. |
| | | Technical note TN1102 updated to version 01.2. |
| | | Technical note TN1104 updated to version 01.3. |
| | | Technical note TN1108 updated to version 01.6. |
| | | Technical note TN1113 updated to version 01.3. |

| Date | Handbook Revision Number | Change Summary |
|-----------------------|--------------------------|--|
| April 2007 (cont.) | 02.8 (cont.) | Technical note TN1149 updated to version 01.2. |
| July 2007 | 02.9 | LatticeECP2/M Family Data Sheet updated to version 02.7. |
| | | Technical note TN1102 updated to version 01.5. |
| | | Technical note TN1103 updated to version 01.5. |
| | | Technical note TN1105 updated to version 01.4. |
| | | Technical note TN1108 updated to version 01.7. |
| August 2007 | 03.0 | Technical note TN1124 updated to version 02.1. |
| August 2007 | 03.1 | LatticeECP2/M Family Data Sheet updated to version 02.8. |
| | | Technical note TN1108 updated to version 01.8. |
| | | Technical note TN1109 updated to version 01.3. |
| September 2007 | 03.2 | Technical note TN1124 updated to version 02.2. |
| | | Technical note TN1108 updated to version 01.9. |
| September 2007 | 03.3 | LatticeECP2/M Family Data Sheet updated to version 02.9. |
| | | Technical note TN1113 updated to version 01.4. |
| December 2007 | 03.4 | Technical note TN1105 updated to version 01.5. |
| | | Technical note TN1124 updated to version 02.3. |
| February 2008 | 03.5 | LatticeECP2/M Family Data Sheet updated to version 03.0. |
| | | Technical note TN1104 updated to version 01.4. |
| | | Technical note TN1108 updated to version 02.0. |
| | | Technical note TN1113 updated to version 01.5. |
| | | Technical note TN1124 updated to version 02.4. |
| April 2008 | 03.6 | Technical note TN1102 updated to version 01.6. |
| | | Technical note TN1104 updated to version 01.5. |
| April 2008 | 03.7 | LatticeECP2/M Family Data Sheet updated to version 03.1. |
| June 2008 | 03.8 | LatticeECP2/M Family Data Sheet updated to version 03.2. |
| | | Technical note TN1124 updated to version 02.5. |
| | | Technical note TN1104 updated to version 01.6. |
| July 2008 | 03.9 | Technical note TN1113 updated to version 01.6. |
| September 2008 | 04.0 | LatticeECP2/M Family Data Sheet updated to version 03.3. |
| | | Technical note TN1124 updated to version 02.6. |
| | | Technical note TN1103 updated to version 01.6. |
| | | Technical note TN1104 updated to version 01.7. |
| November 2008 | 04.1 | Technical note TN1104 updated to version 01.8. |
| | | Technical note TN1108 updated to version 02.1. |
| | | Technical note TN1124 updated to version 02.7. |
| | | Added technical note TN1162, LatticeECP2/M Hardware Checklist. |
| January 2009 | 04.2 | LatticeECP2/M Family Data Sheet updated to version 03.4. |
| | | Technical note TN1124 updated to version 02.8. |
| March 2009 | 04.3 | Technical note TN1102 updated to version 01.7. |
| | | Technical note TN1104 updated to version 01.9. |
| | | Technical note TN1107 updated to version 01.2. |
| | | Technical note TN1113 updated to version 01.7. |
| | | Technical note TN1124 updated to version 02.9. |

| Date | Handbook Revision Number | Change Summary |
|----------------|-----------------------------|--|
| March 2010 | 04.4 | LatticeECP2/M Family Data Sheet updated to version 03.5. |
| | | Technical note TN1103 updated to version 01.9. |
| | | Technical note TN1105 updated to version 01.7. |
| | | Technical note TN1106 updated to version 01.4. |
| | | Technical note TN1113 updated to version 01.8. |
| | | Technical note TN1124 updated to version 03.3. |
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| | | Technical note TN1113 updated to version 01.9. |
| May 2010 | 04.6 | Technical note TN1149 updated to version 01.3. |
| June 2010 | 04.7 | Technical note TN1102 updated to version 01.8. |
| | | Technical note TN1103 updated to version 02.1. |
| | | Technical note TN1105 updated to version 01.7. |
| | | Technical note TN1107 updated to version 01.3. |
| | | Technical note TN1108 updated to version 02.2. |
| | | Technical note TN1109 updated to version 01.4. |
| July 2010 | 04.8 | LatticeECP2/M Family Data Sheet updated to version 03.7. |
| | | Technical note TN1102 updated to version 01.9. |
| April 2011 | 04.9 | LatticeECP2/M Family Data Sheet updated to version 03.8. |
| | | Technical note TN1102 updated to version 01.9. |
| July 2011 | 05.0 | Technical note TN1104 updated to version 02.0. |
| September 2011 | 05.1 | Technical note TN1108 updated to version 02.3. |
| | | Technical note TN1124 updated to version 03.5. |
| January 2012 | 05.2 | Technical note TN1113 updated to version 02.0. |
| February 2012 | 05.3 | LatticeECP2/M Family Data Sheet updated to version 03.9. |

Note: For detailed revision changes, please refer to the revision history for each document.

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